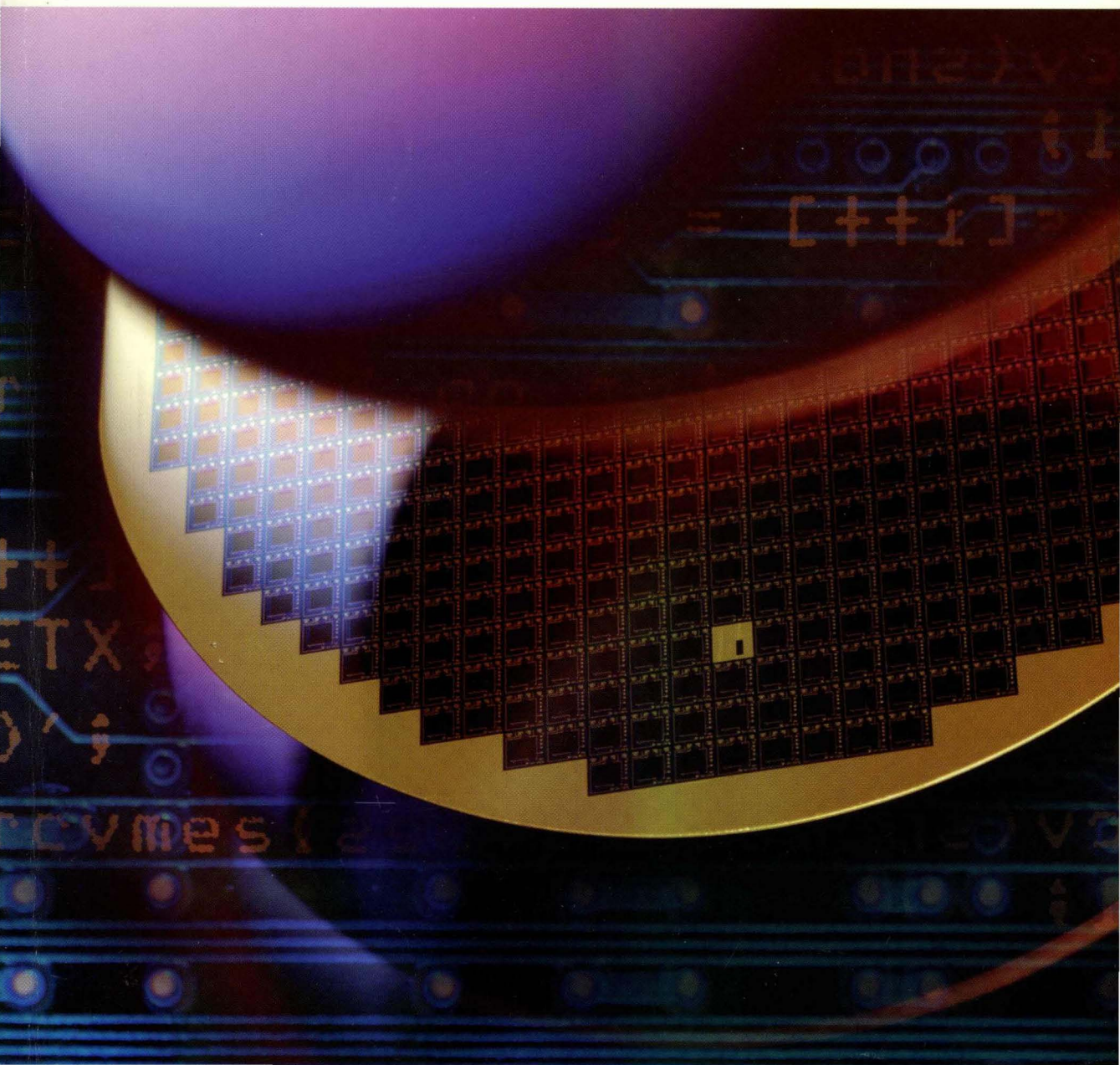


# MOTOROLA SEMICONDUCTOR **MASTER SELECTION GUIDE**



## **Introduction**

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**Advanced Digital  
Consumer Products** **1**

---

**Microcomputer Components** **2**

---

**Logic: Standard, Special  
and Programmable** **3**

---

**Analog and Interface  
Integrated Circuits** **4**

---

**Communications, Power and  
Signal Technologies Group Products** **5**

---

**Product Literature and  
Technical Training** **6**

---

**Device Index and  
Subject Index** **7**

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# **MOTOROLA**

## **Master Selection Guide**

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# Master Selection Guide

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## Where We Stand. . .

### Total Customer Success

Service, speed and facility of response, product quality and reliability are the goals to which we are dedicated. Our commitment to progress such as Six Sigma performance and Cycle Time Reduction are symbolic of a culture in which Total Customer Success is, overwhelmingly, our primary objective.

In today's highly competitive market, selecting the most effective semiconductor components for a given application poses a significant challenge. The range of available functions and the sheer number of components within each unique product line is staggering. Add to this the number of vendors capable of satisfying a portion of the overall system demands and the selection of a cost-effective component complement can be as time consuming as the design of the system itself.

This is where Motorola occupies a unique position among semiconductor manufacturers – one that can significantly shorten the product selection cycle. Please consider these facts:

As a manufacturer of semiconductors since the very beginning of the technology, Motorola has emerged as a leading supplier of such components to the world market.

Motorola's product line is the *broadest* in the industry, capable of filling 75–80% of the many applications for semiconductor devices.

In each of its various product categories, Motorola is a recognized leader, with leading edge products as well as commodity products for mass applications.

Motorola's vast network of sales offices and distributors, augmented by manufacturing centers throughout the world, not only ensures easy communications, cost-effective pricing and rapid service, but guarantees a continuing stream of state-of-the-art products based on world-wide experience and demand.

## How To Use This Guide. . .

This Selection guide is arranged to provide three-way assistance to engineers and technicians in making a first-order selection of components best suited for a specific circuit or system design.

*If you have a device number that needs identification or if you want to know if Motorola manufactures a particular device type:*

1. Turn to the Device Index for a complete listing of Motorola products, and the page numbers where more detailed information is given for these products.

*If you have a device name or acronym and wish to know if Motorola makes such a device:*

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# Table of Contents

## Advanced Digital Consumer Products . . . . . 1.0–1

Advanced Digital Consumer Division (ADCD)	
New Market Focus . . . . .	1.1–1
MPC821/MPC823 RISC Microprocessors and the MC68328 DragonBall™ Integrated Processor . . . . .	1.1–2
LCD Driver Product Summary . . . . .	1.1–3
Monitor On Screen Display (MOSD) . . . . .	1.1–4
Scorpion Graphics Processor (MC92100) . . . . .	1.1–5
M5C™ Series Gate Arrays/M5CB™ Series Standard Cells . . . . .	1.1–6
H4EPlus™ Series Gate Arrays . . . . .	1.1–7
Literature . . . . .	1.1–8
Worldwide Design Centers . . . . .	1.1–8

## Microcomputer Components . . 2.0–1

### Digital Signal Processors . . . . . 2.1–1

DSP56100 — 16–Bit Digital Signal Processors . . . . .	2.1–2
DSP56800 — 16–Bit Digital Signal Processors . . . . .	2.1–3
DSP56000 — 24–Bit Digital Signal Processors . . . . .	2.1–3
DSP56300 — 24–Bit Digital Signal Processors . . . . .	2.1–5
DSP56600—16–Bit Digital Signal Processors . . . . .	2.1–12
DSP96002 — 32–Bit Digital Signal Processors . . . . .	2.1–17
DSP56ADC16 — The Analog–To–Digital Converter . . . . .	2.1–18
DSP Development Tools . . . . .	2.1–18
Application Development Systems . . . . .	2.1–18
Graphical User Interface . . . . .	2.1–19
DSP Development Software . . . . .	2.1–19
Design–In Software Packages . . . . .	2.1–19
C–Compiler Packages . . . . .	2.1–20
C–Compiler Upgrades . . . . .	2.1–20

### The M68000 Family . . . . . 2.2–1

Microprocessors . . . . .	2.2–2
Embedded Controllers . . . . .	2.2–5
Integrated Processors . . . . .	2.2–7
Coprocessors . . . . .	2.2–10
DMA Controllers . . . . .	2.2–10
Network Devices . . . . .	2.2–10
Data Communication Devices . . . . .	2.2–12
General Purpose I/O . . . . .	2.2–12
Fiber Distributed Data Interface . . . . .	2.2–13
Support Software . . . . .	2.2–13

### The M88000 RISC Family . . . . . 2.3–1

Architecture, Performance, and Software Compatibility . . . . .	2.3–2
---	-------

### The M88000 RISC Family (continued)

Microprocessors . . . . .	2.3–2
Cache/Memory Management Units . . . . .	2.3–3

### The PowerPC RISC Family Microprocessors . . . . . 2.4–1

PowerPC™ RISC Microprocessors . . . . .	2.4–2
MPC601 RISC Microprocessor . . . . .	2.4–2
MPC602 RISC Microprocessor . . . . .	2.4–3
MPC603 RISC Microprocessor . . . . .	2.4–3
MPC603e RISC Microprocessor . . . . .	2.4–6
MPC604 RISC Microprocessor . . . . .	2.4–9
MPC604e RISC Microprocessor . . . . .	2.4–9
MPC620 RISC Microprocessor . . . . .	2.4–13
MPC105 PCI Bridge/Memory Controller . . . . .	2.4–15
MPC106 PCI Bridge/Memory Controller . . . . .	2.4–16

### Single–Chip Microcontrollers (CSIC) 2.5–1

M68HC05 CSIC Family . . . . .	2.5–2
M68HC08 Family . . . . .	2.5–13
Development Tools . . . . .	2.5–14
On–Line Help . . . . .	2.5–23

### Single–Chip Microcontrollers (AMCU) . 2.6–1

M68HC11 Family . . . . .	2.6–2
Modular Microcontroller . . . . .	2.6–12
The M68HC16 Family . . . . .	2.6–14
The M68300 Family . . . . .	2.6–19
Development Tools . . . . .	2.6–23
Fuzzy Logic . . . . .	2.6–26
On–Line Help . . . . .	2.6–26
Third–Party Support . . . . .	2.6–27

### LonWorks Products . . . . . 2.7–1

NEURON CHIPS . . . . .	2.7–2
LonWorks Technology Overview and Architecture . . . . .	2.7–5
LonBuilder Developer's Workbench . . . . .	2.7–6
LonWorks Support Tools . . . . .	2.7–7
LonWorks Literature . . . . .	2.7–9

### Memory Products . . . . . 2.8–1

Fast Static RAMs . . . . .	2.8–2
Introduction . . . . .	2.8–2
Application Specific Static RAMs . . . . .	2.8–2
Fast Static RAM Modules . . . . .	2.8–6
Flash Memory . . . . .	2.8–7
Dynamic RAMs . . . . .	2.8–7
Introduction . . . . .	2.8–7
Dynamic RAMs (HCMOS) . . . . .	2.8–8
DRAM Modules . . . . .	2.8–9

# Table of Contents

## Logic: Standard, Special and Programmable ..... 3.0-1

Motorola Logic Families: Which Is Best for You? .....	3.1-1
Motorola Programmable Arrays (MPA) .....	3.1-5
Selection by Function	
Logic Functions .....	3.1-12
Device Index .....	3.1-40
Ordering Information .....	3.1-50
Case Outlines .....	3.1-54
Packaging Information .....	3.1-85
Surface Mount .....	3.1-85
Pin Conversion Tables .....	3.1-85
Tape and Reel .....	3.1-86

## Analog and Interface Integrated Circuits ..... 4.0-1

### Amplifiers and Comparators ..... 4.1-1

Operational Amplifiers .....	4.1-2
Single .....	4.1-2
Dual .....	4.1-3
Quad .....	4.1-4
High Frequency Amplifiers .....	4.1-5
AGC .....	4.1-5
Miscellaneous Amplifiers .....	4.1-6
Bipolar .....	4.1-6
CMOS .....	4.1-6
Comparators .....	4.1-7
Single .....	4.1-7
Dual .....	4.1-7
Quad .....	4.1-7
Package Overview .....	4.1-8

### Power Supply Circuits ..... 4.2-1

Linear Voltage Regulators .....	4.2-2
Fixed Output .....	4.2-2
Adjustable Output .....	4.2-4
Micropower Voltage Regulators for	
Portable Applications .....	4.2-5
80 mA Micropower Voltage Regulator .....	4.2-5
120 mA Micropower Voltage Regulator .....	4.2-6
Micropower Voltage Regulator for	
External Power Transistor .....	4.2-6
Micropower Voltage Regulators with	
On/Off Control .....	4.2-7
Special Regulators .....	4.2-8
Voltage Regulator/Supervisory .....	4.2-8
SCSI Regulator .....	4.2-11
Switching Regulator Control Circuits .....	4.2-12
Single-Ended .....	4.2-12
Single-Ended with On-Chip Power Switch .....	4.2-14
Easy Switcher™ Single-Ended Controllers with	
On-Chip Power Switch .....	4.2-14

### Power Supply Circuits (continued)

Very High Voltage Single-Ended with	
On-Chip Power Switch .....	4.2-15
Double-Ended .....	4.2-15
CMOS Micropower DC-to-DC Converters .....	4.2-17
Single-Ended GreenLine™ Controllers .....	4.2-18
Very High Voltage Switching Regulator .....	4.2-20
Special Switching Regulator Controllers .....	4.2-23
Dual Channel .....	4.2-23
Universal Microprocessor .....	4.2-23
Power Factor .....	4.2-24
Supervisory Circuits .....	4.2-27
Overvoltage Crowbar Sensing .....	4.2-27
Over/Undervoltage Protection .....	4.2-27
CMOS Micropower Undervoltage Sensing .....	4.2-28
CMOS Micropower Undervoltage Sensing with	
Output Delay .....	4.2-29
Undervoltage Sensing .....	4.2-30
Universal Voltage Monitor .....	4.2-31
Battery Management Circuits .....	4.2-32
Battery Charger ICs .....	4.2-32
Battery Pack ICs .....	4.2-34
MOSFET/IGBT Drivers .....	4.2-38
High Speed Dual Drivers .....	4.2-38
Single IGBT Driver .....	4.2-38
Package Overview .....	4.2-40

### Power/Motor Control Circuits ..... 4.3-1

Power Controllers .....	4.3-2
Zero Voltage Switches .....	4.3-2
Zero Voltage Controller .....	4.3-3
High-Side Driver Switch .....	4.3-4
Motor Controllers .....	4.3-4
Brushless DC Motor Controllers .....	4.3-4
Closed-Loop Brushless Motor Adapter .....	4.3-7
DC Servo Motor Controller/Driver .....	4.3-8
Stepper Motor Driver .....	4.3-9
Universal Motor Speed Controllers .....	4.3-10
Package Overview .....	4.3-11

### Voltage References ..... 4.4-1

Precision Low Voltage References .....	4.4-2
Package Overview .....	4.4-2

### Data Conversion ..... 4.5-1

Data Conversion .....	4.5-2
A-D Converters .....	4.5-2
CMOS .....	4.5-2
Bipolar .....	4.5-2
Sigma-Delta .....	4.5-2
D-A Converters .....	4.5-3
CMOS .....	4.5-3
Sigma-Delta .....	4.5-3
Package Overview .....	4.5-4



# Table of Contents

## Analog and Interface

### Integrated Circuits (continued)

#### Interface Circuits ..... 4.6-1

Enhanced Ethernet Transceiver .....	4.6-2
ISO 8802-3[IEEE 802.3] 10BASE-T Transceiver ..	4.6-3
Hex EIA-485 Transceiver with Three-State Outputs .....	4.6-4
5.0 V, 200 M-Bit/Sec PR-IV Hard Disk Drive Read Channel .....	4.6-5
Line Receivers .....	4.6-7
EIA Standard .....	4.6-7
Line Drivers .....	4.6-7
EIA Standard .....	4.6-7
Line Transceivers .....	4.6-7
EIA-232-E/V.28 CMOS Drivers/Receivers ..	4.6-7
Peripheral Drivers .....	4.6-8
IEEE 802.3 Transceivers .....	4.6-8
Read/Write Channel .....	4.6-8
Drive Read Channel .....	4.6-8
Inkjet Drivers .....	4.6-8
28-Channel Inkjet Driver .....	4.6-8
CMOS Display Drivers .....	4.6-9
Package Overview .....	4.6-10

#### Communication Circuits ..... 4.7-1

RF Communications .....	4.7-2
RF Front End ICs .....	4.7-2
Wideband IFs .....	4.7-2
Wideband Single Conversion Receivers ..	4.7-2
Narrowband Single Conversion Receivers ..	4.7-2
Narrowband Dual Conversion Receivers ..	4.7-3
Universal Cordless Phone Subsystem ICs ..	4.7-3
Transmitters .....	4.7-3
Balanced Modulator/Demodulator .....	4.7-4
Infrared Transceiver .....	4.7-4
Telecommunications .....	4.7-11
Subscriber Loop Interface Circuit .....	4.7-11
PBX Architecture (Analog Transmission) ..	4.7-12
PCM Monocircuits .....	4.7-12
Dual Tone Multiple Frequency Receiver ..	4.7-15
ISDN Voice/Data Circuits .....	4.7-15
Integrated Services Digital Network ..	4.7-15
Second Generation U-Interface Transceivers ..	4.7-16
Second Generation S/T-Interface Transceivers ..	4.7-16
Dual Data Link Controller .....	4.7-17
Voice/Data Communication (Digital Transmission) ..	4.7-18
Universal Digital Loop Transceiver ..	4.7-18
ISDN Universal Digital Loop Transceiver II ..	4.7-19
Electronic Telephone Circuit .....	4.7-19
Tone Ringers .....	4.7-20
Speech Networks .....	4.7-21
Speakerphones .....	4.7-25
Voice Switched Speakerphone Circuit ..	4.7-25

### Communication Circuits (continued)

Voice Switched Speakerphone with μProcessor Interface .....	4.7-27
Voice Switched Speakerphone Circuit .....	4.7-28
Telephone Line Interface and Speakerphone Circuit .....	4.7-29
Family of Speakerphone ICs .....	4.7-30
Telephone Accessory Circuits .....	4.7-31
Audio Amplifier .....	4.7-31
Current Mode Switching Regulator .....	4.7-31
300 Baud FSK Modems .....	4.7-32
ADPCM Transcoder .....	4.7-32
Calling Line Identification (CLID) Receiver ..	4.7-33
CVSD Modulator/Demodulator .....	4.7-34
Summary of Bipolar Telecommunications Circuits .....	4.7-35
Phase-Locked Loop Components .....	4.7-38
PLL Frequency Synthesizers .....	4.7-38
Phase-Locked Loop Functions .....	4.7-39
Package Overview .....	4.7-41

#### Consumer Electronic Circuits ..... 4.8-1

Entertainment Radio Receiver Circuits .....	4.8-2
Entertainment Receiver RF/IF .....	4.8-2
C-Quam® AM Stereo Decoders .....	4.8-2
Audio Amplifiers .....	4.8-2
Video Circuits .....	4.8-3
Encoders .....	4.8-3
TV Decoder .....	4.8-3
Video Capture Chip Sets .....	4.8-3
TV Picture-in-Picture .....	4.8-3
Comb Filters .....	4.8-3
Deflection .....	4.8-3
TV IF Circuits .....	4.8-3
Tuner PLL Circuits .....	4.8-4
Modulator .....	4.8-4
Video Data Converters .....	4.8-4
Monitor Subsystem .....	4.8-4
Miscellaneous .....	4.8-4
Circuit Descriptions and Diagrams .....	4.8-6
Package Overview .....	4.8-24

#### Automotive Electronic Circuits ..... 4.9-1

Voltage Regulators .....	4.9-2
Electronic Ignition .....	4.9-2
Special Functions .....	4.9-3
Package Overview .....	4.9-13

#### Other Analog Circuits ..... 4.10-1

Timing Circuits .....	4.10-2
Singles .....	4.10-2
Duals .....	4.10-2
Multipliers .....	4.10-2
Linear Four-Quadrant Multipliers .....	4.10-2
Smoke Detectors (CMOS) .....	4.10-3
Package Overview .....	4.10-4

# Table of Contents

## Analog and Interface

### Integrated Circuits (continued)

#### Tape and Reel Options ..... 4.11–1

Tape and Reel Configurations ..... 4.11–2

Tape and Reel Information Table ..... 4.11–4

Analog MPQ Table ..... 4.11–5

## Communications, Power and Signal Technologies Group

### Products ..... 5.0–1

#### Small Signal Transistors, FETs and Diodes ..... 5.1–1

Bipolar Transistors ..... 5.1–2

Plastic–Encapsulated Transistors ..... 5.1–2

Plastic–Encapsulated Multiple Transistors ..... 5.1–8

Plastic–Encapsulated Surface  
Mount Transistors ..... 5.1–10

Metal–Can Transistors ..... 5.1–18

Field–Effect Transistors ..... 5.1–20

JFETs ..... 5.1–20

MOSFETs ..... 5.1–22

Surface Mount FETs ..... 5.1–23

Tuning and Switching Diodes ..... 5.1–25

Tuning Diodes — Abrupt Junction ..... 5.1–25

Tuning Diodes — Hyper–Abrupt Junction ..... 5.1–29

Schottky Diodes ..... 5.1–33

Switching Diodes ..... 5.1–35

Multiple Switching Diodes ..... 5.1–39

GreenLine Devices ..... 5.1–41

Small Signal Multi–integrated Devices ..... 5.1–43

## TVS/Zeners

### Transient Voltage Suppressors / Zener

#### Regulator and Reference Diodes .. 5.2–1

TVS (Transient Voltage Suppressors) ..... 5.2–2

General–Purpose ..... 5.2–2

Axial Leaded for Through–hole Designs ..... 5.2–2

Surface Mount Packages ..... 5.2–9

Overvoltage Transient Suppressors ..... 5.2–18

Zener Diodes ..... 5.2–19

Voltage Regulator Diodes ..... 5.2–19

Notes — Axial Leaded Chart ..... 5.2–23

Notes — Surface Mount Chart ..... 5.2–26

Voltage Reference Diodes ..... 5.2–34

Current Regulator Diodes ..... 5.2–34

#### Hybrid Power Module Operation .. 5.3–1

Integrated Power Stage IGBT ..... 5.3–2

## TMOS Power MOSFETs Products .. 5.4–1

TMOS Power MOSFETs ..... 5.4–1

TMOS Power MOSFETs Numbering System ..... 5.4–2

HDTMOS™ Power MOSFETs ..... 5.4–3

TMOS V ..... 5.4–5

SMARTDISCRETES Products ..... 5.4–7

N–Channel MOSFETs ..... 5.4–8

SO–8 MiniMOS ..... 5.4–8

SO–8 EZFET ..... 5.4–9

Micro8 ..... 5.4–9

SOT–223 ..... 5.4–9

DPAK ..... 5.4–10

D<sup>2</sup>PAK ..... 5.4–11

D<sup>3</sup>PAK ..... 5.4–12

TO–220AB ..... 5.4–13

TO–247 ..... 5.4–15

TO–264 ..... 5.4–16

P–Channel MOSFETs ..... 5.4–17

SO–8 MiniMOS ..... 5.4–17

Micro8 ..... 5.4–17

SOT–223 ..... 5.4–18

DPAK ..... 5.4–18

D<sup>2</sup>PAK ..... 5.4–19

TO–220AB ..... 5.4–19

Logic Level MOSFETs ..... 5.4–20

SOT–223 ..... 5.4–20

DPAK ..... 5.4–20

D<sup>2</sup>PAK ..... 5.4–21

TO–220AB ..... 5.4–21

Insulated Gate Bipolar Transistors (IGBTs) ..... 5.4–22

N–Channel ..... 5.4–22

Ignition IGBTs ..... 5.4–22

Standard and Copackaged IGBTs ..... 5.4–22

## Bipolar Power Transistors ..... 5.5–1

Bipolar Power Transistors ..... 5.5–2

Selection by Package ..... 5.5–2

Plastic TO–220AB ..... 5.5–3

Plastic TO–218 Type ..... 5.5–6

Plastic TO–247 Type ..... 5.5–7

Large Plastic TO–264 ..... 5.5–8

Plastic TO–225AA Type

(Formerly TO–126 Type) ..... 5.5–8

DPAK – Surface Mount Power Packages ..... 5.5–10

Metal TO–204AA (Formerly TO–3),

TO–204AE ..... 5.5–11

Audio ..... 5.5–15

Electronic Lamp Ballasts ..... 5.5–16

# Table of Contents

## Communications, Power and Signal Technologies Group Products (continued)

<b>Rectifiers</b> .....	<b>5.6-1</b>
Rectifier Numbering System .....	5.6-2
Application Specific Rectifiers .....	5.6-3
Low V <sub>F</sub> Schottky .....	5.6-3
MEGAHERTZ .....	5.6-3
SCANSWITCH .....	5.6-3
Automotive Transient Suppressors .....	5.6-3
SWITCHMODE™ Rectifiers .....	5.6-4
Surface Mount Schottky .....	5.6-4
Axial Lead Schottky .....	5.6-6
TO-220 Type Schottky .....	5.6-7
TO-218 Types and TO-247 Schottky .....	5.6-8
POWERTAP II .....	5.6-9
Ultrafast Rectifiers .....	5.6-10
Surface Mount Ultrafast .....	5.6-10
Axial Lead Ultrafast .....	5.6-10
TO-220 Type Ultrafast .....	5.6-11
TO-218 Types and TO-247 Ultrafast .....	5.6-12
POWERTAP II .....	5.6-12
Fast Recovery Rectifiers/General Purpose Rectifiers .....	5.6-13
GaAs Rectifiers Power Manager™ .....	5.6-14
<b>Thyristors and Triggers</b> .....	<b>5.7-1</b>
Silicon Controlled Rectifiers .....	5.7-2
TRIACs .....	5.7-7
General Purpose .....	5.7-7
Thyristor Triggers .....	5.7-14
SIDACs .....	5.7-14
Programmable Unijunction Transistors — PUT .....	5.7-14
Silicon Bidirectional Switch (SBS) .....	5.7-14
High Voltage Bidirectional TVS Devices .....	5.7-14
<b>Optoelectronic Devices</b> .....	<b>5.8-1</b>
Optoisolators .....	5.8-2
Safety Standard Approvals for 6-Pin Optoisolators .....	5.8-2
Regulatory Approval Certification Index .....	5.8-2
VDE Approved Optoisolators .....	5.8-3
6-Pin Dual In-line Package .....	5.8-6
Small Outline — Surface Mount .....	5.8-9
POWER OPTO Isolators .....	5.8-10
<b>Sensors</b> .....	<b>5.9-1</b>
Introduction .....	5.9-2
The Basic Structure .....	5.9-2
Motorola's Patented X-ducer .....	5.9-2
Linearity .....	5.9-3

## Sensors (continued)

Operation .....	5.9-3
Typical Electrical Characteristic Curves .....	5.9-4
Unibody Cross-sectional Drawings .....	5.9-5
Pressure Side Identification .....	5.9-6
Selector Guide .....	5.9-7
Reference Table .....	5.9-13
Packaging Options .....	5.9-14

## RF Products

<b>RF Products</b> .....	<b>5.10-1</b>
RF Discrete Transistors .....	5.10-2
RF Power MOSFETs .....	5.10-4
RF Power Bipolar Transistors .....	5.10-7
HF Transistors .....	5.10-7
VHF Transistors .....	5.10-7
UHF Transistors .....	5.10-8
900 MHz Transistors .....	5.10-9
1.5 GHz Transistors .....	5.10-10
Microwave Transistors .....	5.10-10
Linear Transistors .....	5.10-12
RF Medium Power Transistors .....	5.10-14
Discrete Wireless Transmitter Devices .....	5.10-15
RF Small Signal Transistors .....	5.10-16
Selection by Package .....	5.10-17
Plastic SOE Case .....	5.10-17
Ceramic SOE Case .....	5.10-20
Selection by Application .....	5.10-21
Low Noise .....	5.10-21
CATV, MATV and Class A Linear .....	5.10-22
RF Monolithic Integrated Circuits .....	5.10-23
Switching .....	5.10-24
Antenna Switches .....	5.10-24
Receiver Functions .....	5.10-24
General Purpose Integrated Circuits .....	5.10-24
900 MHz Front End .....	5.10-24
1.5-2.2 GHz Front End .....	5.10-24
2.4 GHz Front End .....	5.10-25
Transmitter Functions .....	5.10-25
General Purpose Integrated Circuits .....	5.10-25
900 MHz Transmit Chain .....	5.10-26
1.5-2.2 GHz Transmit Chain .....	5.10-27
2.4 GHz Transmit Chain .....	5.10-28
RF Amplifier Modules .....	5.10-29
Land Mobile/Portable .....	5.10-31
Wideband Linear Amplifiers .....	5.10-34
TV Transmitters .....	5.10-35
CATV Distribution Amplifiers .....	5.10-36
Fiber Optic Receivers .....	5.10-36
Forward Amplifiers .....	5.10-36
Reverse Amplifiers .....	5.10-40

## Surface Mount Information

Information for Using Surface Mount Packages .....	5.11-2
Footprints for Soldering .....	5.11-5



# Table of Contents

## Communications, Power and Signal Technologies Group Products (continued)

### Tape and Reel Specifications and Packaging Specifications . . . . 5.12-1

Tape and Reel Specifications . . . . .	5.12-2
Embossed Tape and Reel Ordering Information . . . . .	5.12-3
Embossed Tape and Reel Data for Discretes . . . . .	5.12-4
Lead Tape Packaging Standards for Axial-Lead Components . . . . .	5.12-6
Packaging Specifications . . . . .	5.12-7
TO-92 EIA Radial Tape in Fan Fold Box or on Reel . . . . .	5.12-7
Fan Fold Box Styles . . . . .	5.12-9
Adhesion Pull Tests . . . . .	5.12-9
Reel Styles . . . . .	5.12-10
DO-35, DO-41, Surmetic 30 Radial Tape in Fan Fold Box or On Reel . . . . .	5.12-11

## Product Literature and Technical Training . . . . . 6.0-1

Technical Data Services . . . . .	6.1-1
Motorola Semiconductor Master Selection Guide . . . . .	6.1-1
"IMAGINE" SPS Customer Magazine . . . . .	6.1-1
Mfax — Touch-Tone Fax . . . . .	6.1-1
Internet Server . . . . .	6.1-1
Motorola Data and Application Literature . . . . .	6.1-2
Motorola Application Literature . . . . .	6.1-6
Technical Training . . . . .	6.1-7

## Device Index and Subject Index . . . . . 7.0-1

Device Index . . . . .	7.1-1
General Index . . . . .	7.2-1
Subject Index . . . . .	7.2-9



# Advanced Digital Consumer Products

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## In Brief . . .

Motorola supports strategic programs and co-development partnerships to accelerate the availability of advanced digital consumer products.

	<b>Page</b>
Advanced Digital Consumer Division (ADCD)	
New Market Focus . . . . .	1.1-1
MPC821/MPC823 RISC Microprocessors and the MC68328 DragonBall™ Integrated Processor . . . . .	1.1-2
LCD Driver Product Summary . . . . .	1.1-3
Monitor On Screen Display (MOSD) . . . . .	1.1-4
Scorpion Graphics Processor (MC92100) . . . . .	1.1-5
M5C™ Series Gate Arrays/M5CB™ Series Standard Cells . . . . .	1.1-6
H4EPlus™ Series Gate Arrays . . . . .	1.1-7
Literature . . . . .	1.1-8
Worldwide Design Centers . . . . .	1.1-8

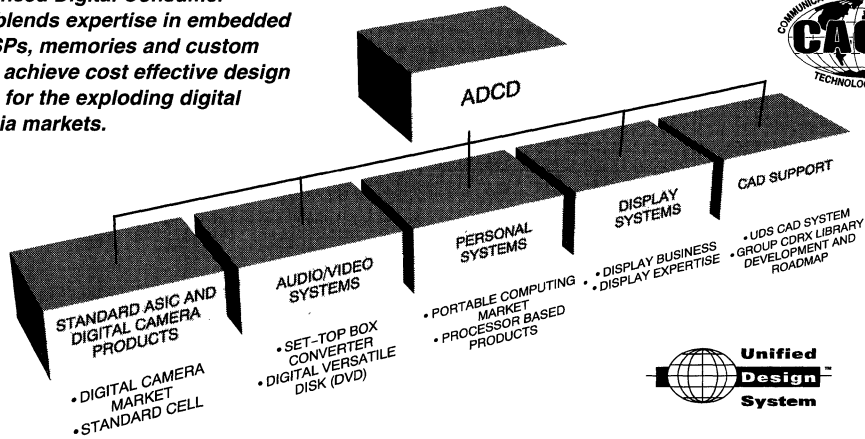




# Advanced Digital Consumer Division (ADCD)

## New Market Focus

The Advanced Digital Consumer Division blends expertise in embedded cores, DSPs, memories and custom silicon to achieve cost effective design solutions for the exploding digital multimedia markets.



### Standard ASIC and Digital Camera Products

The ADC Division champions standard cell methodologies and libraries to provide a technology base for use across the Communications and Advanced Consumer Technologies Group (CACTG). The ADC Division is taking the lead role in the area of systems integration. Mixed (analog + digital) signal system integration is ideally suited to 'camera-on-a-chip' concepts for the digital camera market.

### Audio/Video Systems

Focused to provide leadership products in multimedia markets, such as Set-Top Box (STB) converters, Advanced TV, and Digital Versatile Disk (DVD).

### Set-Top Box Converters

One application of digital set-top boxes is in digital cable TV distribution networks. These systems expand the number of available channels while delivering high quality digital video and audio via cable to the home.

Cable operators are also offering high-speed data services for computer to computer communications. These modems make it possible for ordinary PCs to access the Internet at Ethernet speeds (10 Mbit/second) or higher.

### Personal Systems

Personal Systems develops integrated microprocessors based on Motorola's 68K (M68328) and Embedded PowerPC™ (MPC821/MPC823) architectures for digital consumer products such as PDAs, Portable Clients, Smart Phones, Digital Cameras, and Web Appliances.

These highly integrated microprocessors include the peripherals most commonly required for these markets, such as LCD controller, serial interfaces, USB, IrDA, PCMCIA, etc. They provide solutions for systems requiring low cost, low power, and high performance using PowerPC™ and Embedded DSP to provide over 100 MIPS. By incorporating industry standard architectures these processors are backed by superior development tools and OS support. Some examples include Microware (OS-9), Microsoft (WindowsCE — 821/823 only), ISI (pSOS), WindRiver (VxWorks), Diab, SDS, Metrowerks, HP, Applied, and others. Personal Systems also provides reference designs for HandHeld PC, Digital Cameras and Web Appliances to shorten new product development time.

### Display Systems

Products that provide best-in-class display system (flat panel and monitor) solutions for high growth, high volume communication and consumer electronic products. LCD Drivers for applications ranging from pager and cellular telephone displays to mid-range drivers for electronic translators, games, etc., to large LCD drivers for computer VGA displays.

### CAD Support

Focused on developing next generation Cell-based libraries for delivery within the UDS design system.

### Unified Design System (UDS 1.0 ASIC) – Now Available

The consumer marketplace is driven by low cost, high performance, and short development schedules. The UDS system rapidly takes a design from the system level to physical implementation, allowing designers more time to focus on system level design trade-offs and IC performance.

Now available to Sun, Solaris, and HP platform ASIC gate array customers. This CAD system is based upon the Open Architecture CAD System (OACS) and includes new graphical interfaces, silicon technology features, and enhancements to OACS tools.

### Scorpion Chip (MC92100)

#### Prototypes available – June '97

The MC92100 is a graphics display generator and digital video encoder for analog and digital video systems. The chip provides a highly integrated solution for Intelligent TV (iTV), Set-Top Box (STB), and Digital Versatile Disk (DVD) applications. The Scorpion chip support team offers customers the design talents of Motorola's Phoenix Technology Center combined with the silicon integration skills of the ADC Division.

### Low Cost Plastic Ball Grid Array

#### (LCPBGA) Packages – Now Available

The ADC Division is offering a new BGA family designed to match the cost of plastic QFP packages in the 100 - 200 lead range. The low cost BGA family presently includes packages with 100, 144, and 196 leads. The family employs a 1.0 mm solderball pitch which provides a very small, thin, and light package ideal for consumer products.

# **MPC821/MPC823 RISC Microprocessors and the MC68328 DragonBall™ Integrated Processor**

---

The enhanced architecture of PowerPC™ microprocessors, created to drive the most powerful personal computers in the world, is now changing the world of embedded processing. It's the optimum solution any time:

- system performance is a principal goal,
- you need a range of software-compatible solutions that match your product's performance levels,
- you need a full computer architecture, or
- your product's software is closely related to PC software technology.

All embedded PowerPC™ microprocessors benefit — both technologically and economically — from their desktop heritage. Cutting-edge technologies are shared with desktop versions, from integral FPUs to the use of sub-half-micron process. And economies of scale make them more cost-effective than other RISC architectures.

## **MPC821 RISC Microprocessor**

- Embedded PowerPC™ Core provides 66 MIPS (using Dhrystone 2.1) or 115K Dhrystones 2.1 at 50 MHz and 33 MIPS (using Dhrystone 2.1) or 58K Dhrystones 2.1 at 25 MHz
- Data Bus Dynamic Bus Sizing for 8-, 16-, and 32-Bit Busses
- Completely Static Design (0–50 MHz Operation)
- Four Baud Rate Generators
- Two Serial Communication Controllers (SCC)
- Two Serial Management Channels (SMCs)
- One Serial Peripheral Interface (SPI)
- One Interprocessor-Integrated Circuit (I(2)C) Port
- Time-Slot Assigner
- Parallel Interface Port
- General-Purpose Timers
- Memory Controller (Eight Banks)
- System Interface Unit (SIU)
- LCD Interface Controller
- PCMCIA Controller
- Low-Power Support
- Debug Interface
- 3.3 V Operation with TTL Compatibility on I/O Pins

## **MPC823 RISC Microprocessor**

- Embedded PowerPC™ Core provides 66 MIPS (using Dhrystone 2.1) or 115K Dhrystones 2.1 at 50 MHz and 33 MIPS (using Dhrystone 2.1) or 58K Dhrystones 2.1 at 25 MHz
- Data Bus Dynamic Bus Sizing for 8-, 16-, and 32-Bit Busses
- Completely Static Design (0–50 MHz Operation)
- Two Baud Rate Generators
- One Serial Communication Controller (SCC)
- Two Serial Management Channels (SMCs)
- One Serial Peripheral Interface (SPI)
- One Interprocessor-Integrated Circuit (I(2)C) Port
- Time-Slot Assigner
- General-Purpose Timers
- Memory Controller (Eight Banks)
- System Interface Unit (SIU)
- LCD Interface Controller
- PCMCIA Controller
- Low-Power Support
- Debug Interface
- 3.3 V Operation with TTL Compatibility on I/O Pins

## **MC68328 DragonBall™ Integrated Processor**

- Static 68EC000 Core
- PCMCIA Support
- LCD Controller
- Real Time Clock
- Pulse Width Modulator
- Serial Peripheral Interface
- UART
- Two 16-bit Timer/Counters
- 16 Chip Selects
- System Integration
- Low Power Consumption
- 24 Address Lines, 16 Data Lines
- 2.7 MIPS @ 16 MHz
- Available in 16 MHz
- Available in 3.3V

# LCD Driver Product Summary

Part Number	Description	System	Application Examples	Display Size Examples	Package
<b>Segmented LCD Driver for Low MUX Application</b>					
MC14LC5003 MC14LC5004	4 MUX, total 128 Segments, Serial In 4 MUX, total 128 Segments, IIC	Low MUX, General MCU	Fax Machines, Pager, Digital Meter, Home Appliances	32 x 4	QFP, Bare die
<b>DragonKat™ Series LCD Driver Kits with MC68HC05L10/L11</b>					
MC141511A	DragonKat 1+ Slave Driver, 32/41 MUX, 128 Segments	DragonKat 1+ MC68HC05L10	Databank, Pager, Organizer, Games	128 x 32/41, 256 x 32/41	TAB, Bare die
MC141512 MC141514 MC141515 MC141519	DragonKat 2 Backplane Driver, 146 MUX, 80 Backplanes DragonKat 2 Segment Driver, 146 MUX, 160 Segments DragonKat 2 Backplane Driver, 146 MUX, 160 Backplanes DragonKat 2 Segment Driver, 80 MUX, 160 Segments	DragonKat 2 MC68HC05L11	Transistor, Dictionary, Pen-based Organizer, Low Cost PDA	160 x 80, 320 x 146, 320 x 160	TAB
MC141516 MC141518	64 MUX LCD Backplane Driver, 64 Backplane Outputs 64 MUX LCD Segment Driver, 80 Segment Outputs	DragonKat 2 MC68HC05L11, other MCU with SPI	Pager, Games, Dictionary	80 x 64, 160 x 64, 240 x 64	TQFP, Bare die
<b>TFT LCD Driver Accepts RGB Signal Inputs</b>					
MC141522 MC141524	TFT-LCD Gate (Row) Driver, 120 Row Outputs TFT-LCD Source (Column) Driver, 120 Column Outputs	Active LCD	Portable TV, Projector	480 x 240, 720 x 480	TAB
<b>MC14158X Series LCD Driver with Commons, Segments, Annunciators "All In One" Chip</b>					
MC141531 MC141532 MC141533 MC141535 MC141537 MC141539	17 Com, 120 Seg, 3 Annunciators 33 Com, 120 Seg, 4 Annunciators 33 Com, 120 Seg, 4 Annun, Split Com 17 Com, 161 Seg, 4 Annunciators 16 Com, 120 Seg, 3 Annunciators 32 Com, 120 Seg, 4 Annunciators	General MCU, 6800, 68K (Parallel Interface)	Mobile Communication Devices, Pager, Cellular, PHS	120 x 17 120 x 33 120 x 33 161 x 17 120 x 16 120 x 32	TAB, Bare die, Au bump die
<b>300 MUX LCD Driver without Display DRAM</b>					
MC141562 MC141563	LCD Common Driver, 100 Com o/p LCD Segment Driver, 80 Seg o/p	DragonBall™ MC68328, General MCU with LCD Controller	PDA, Palm-top, Sub-notebook	320 x 200, 320 x 240, 640 x 200	TAB, Au bump die
<b>MC14180X Series LCD Driver for Cellular Phone/PHS Applications</b>					
MC141800A	65 Common, 12B Segment o/p	General MCU, 6800, 68K (IIC, Parallel Interface)	Cellular Phone, PHS Large Display Pager	128 x 65, 128 x 64 plus 128 Icons	TAB, Au bump die

# Monitor On Screen Display (MOSD)

Motorola's MOSD family includes **ES**(EMOSD & SMOSD) and **AG**(AMOSD2 & GMOSD) **pin-compatible** series which provide easy-to-use, sophisticated hardware to generate on screen display function for Monitor, LCD, TV and Display Systems. In **ES series**, either 128/256 number of font's device can be chosen and 8 real time programmable **RAM** are equipped for flexible icon design for different OEM models. For **AG series**, besides 128/256 font option, both devices provide a

**SVGA** resolution display with maximum dot clock at **92.2MHz**. The two series offer DAC integration, programmable display resolutions and user-friendly display attribute controls. Users can freely choose Motorola MOSD devices to fulfill their full application spectrum: from low-end to high-end, from cost-sensitive to feature-oriented. In addition, **custom mask ROM** is welcome for tailor-made model design. Details of the MOSD devices can be found in the following section.

	<b>EMOSD Enhance MC141541</b>	<b>SMOSD Super MC141548/9</b>	<b>AMOSD2 Advance MC141546/7</b>	<b>GMOSD Graphic MC141542/5</b>
<b>Display Area</b>	10R x 24C	15R x 30C	15R x 30C	15R x 30C
<b>Color</b>	8	8	8	8
<b>Intensity</b>	High	High/Low	High/Low	High/Low
<b>Windows</b>	3	4	4	4
<b>No. of Font</b>	128	256	128	256
<b>ROM</b>	120	248	128	288
<b>Mask ROM</b>	Yes	Yes	Yes	Yes
<b>RAM</b>	8	8	0	0
<b>Font Matrix</b>	10 x 16	10 x 16	12 x 18	12 x 18
<b>Resolution</b>	EGA	VGA	SVGA	SVGA
<b>Max. Dot Clk.</b>	52.8 MHz	76.8 MHz	92.2 MHz	92.2 MHz
<b>Max Freq.</b>	110 KHz	120 KHz	120 KHz	120 KHz
<b>DAC Integration</b>	0	12	12	12
<b>16 DIP, 0 DAC</b>	MC141541P	MC141549P	MC141547P	MC141545P
<b>24 DIP, 8 DAC</b>	N.A.	MC141548P	MC141546P	MC141542P
<b>28 SOIC, 12 DAC</b>	N.A.	Custom	Custom	Custom
<b>Special Display Feature</b>	<ul style="list-style-type: none"> <li>— Double Height</li> <li>— Double Width</li> <li>— Shadowing</li> <li>— Bordering</li> </ul>	<ul style="list-style-type: none"> <li>EMOSD Plus</li> <li>— Windows Shadow</li> <li>— Blinking</li> <li>— Fade-In/Fade-Out</li> <li>— Automatic Height</li> <li>— Icon Intensity</li> <li>— Windows Intensity</li> </ul>	<ul style="list-style-type: none"> <li>— Double Height</li> <li>— Double Width</li> <li>— Shadowing</li> <li>— Bordering</li> <li>— Automatic Height</li> <li>— Spacing Control</li> <li>— Windows Intensity</li> </ul>	<ul style="list-style-type: none"> <li>AMOSD2 Plus</li> <li>— 16 Multi-color Font</li> <li>— 7 Color Background</li> <li>— Windows Shadow</li> <li>— Blinking</li> <li>— Fade-In/Fade-Out</li> <li>— Automatic Height</li> <li>— Icon Intensity</li> </ul>
<b>Data Sheet</b>	MC141541/D	MC141548/D	MC141546/D	MC141542/D
<b>Evaluation</b>	MC141541EVK	MC141548EVK	MC141546EVK	MC141542EVK

# Scorpion Graphics Processor (MC92100)

## Graphics Display Generator, SRAM Controller, and Digital Video Encoder – on a single chip

Scorpion is a graphic display generator and NTSC/PAL digital video encoder for analog and digital video systems including DVD, STB, and Internet TV applications. The display architecture has been designed to provide a high-quality television-oriented graphics overlay. The graphics overlay matches the resolution and color depth of the NTSC/PAL baseband video and optimizes memory usage. Scorpion can provide generation of true color graphics, mixing of video and graphics in 1.6% steps (64 different levels), and control and display on four image layers. Scorpion is controlled by high-level language instructions from a host processor (PowerPC™ or Coldfire™).

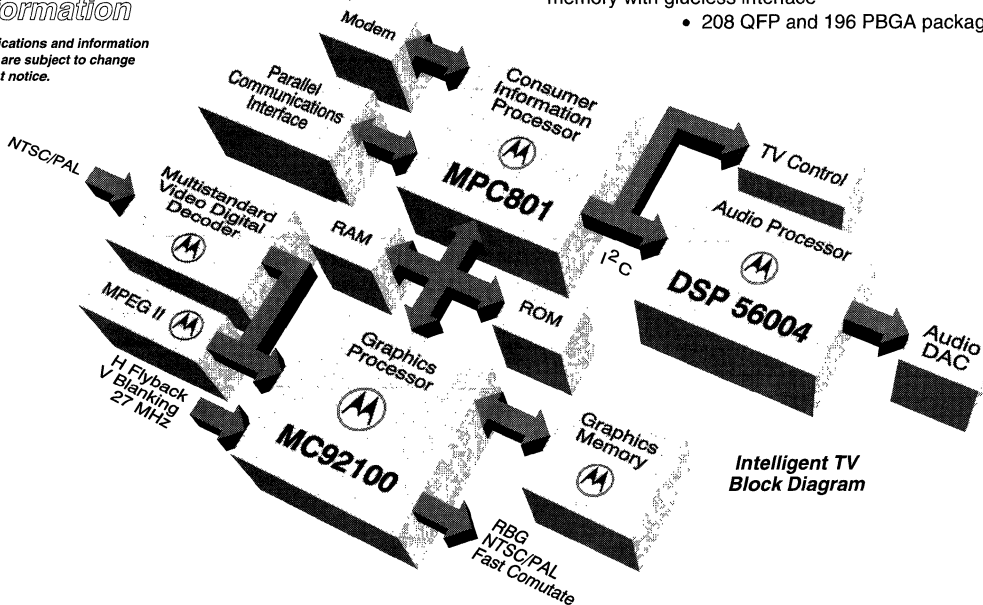
The digital video encoder accepts a CCIR-656 data stream with embedded synchronization codes or it may be genlocked with a television horizontal flyback and vertical synchronization signal. Scorpion supports both a composite and separate luma and chroma output (S-VHS) analog video generation, or composite and RGB. It also includes Macrovision™ generation of copy protection and a closed caption inserter for line 21.

## MC92100 Features

- Graphics controller compatible with high-level languages
- Microware OS9000 (for PowerPC) MAUI dedicated software driver available
- Host processor interface for PowerPC and Coldfire
- True color graphics generator at VGA density with video/graphics mixing in 1.6% steps (64 levels)
- True color graphics generator for NTSC (720 x 480 pixels) and PAL (720 x 576 pixels)
- Selectable conversion from CCIR-656 aspect ratio to square pixels
- Selectable vertical filtering for flicker reduction
- Graphics matched to resolution and color depth of high-quality NTSC/PAL television graphics overlay
- Uses 12/16 bits per pixel to store images equivalent to 24-bit-per-pixel computer images and CCIR-601 data streams and/or a 2/4/8-bit color look-up table (CLUT)
- Maximum of two viewports on any horizontal line
- Multiple viewports vertically
- Supports four image levels including video, two viewports, and hardware cursor
- Graphics display requires less than 30% of memory bandwidth per viewport, allowing rapid processor updates
- Digital video encoder for converting CCIR-656 to composite and S-VHS analog video
- Macrovision generator for copy protection and closed caption inserter for line 21 data
- SDRAM controller for shared system and graphics memory with glueless interface
  - 208 QFP and 196 PBGA packages

## Preliminary Information

Specifications and information herein are subject to change without notice.



# M5C™ Series Gate Arrays/M5CB™ Series Standard Cells

## Deep Sub-Micron CMOS Process

The M5C/CB Series feature performance optimized 3.3 V and 5 V tolerant I/O capability, high-speed interfaces, and analog PLLs for chip-to-chip clock skew management. The gate length has been reduced to 0.45  $\mu\text{m}$  nominal  $L_{eff}$  to provide improved 3.3 V performance.

The M5C/CB Series utilizes Motorola's standard 0.5 micron CMOS process for logic, the same one used for products like the 68060 and low power 68040. The process has advanced features such as tungsten plugged, stacked vias and contacts, and planarized metalization.

High-speed SCI-LVDS, GTL, PCI and PECL macros offer enhanced chip-to-chip communication. Motorola's SCI-LVDS (Low-Voltage Differential Swing) interface enables differential operation up to 311 MHz. Analog PLLs may be embedded into three corners of the die for on-chip 50% duty cycle clock signals up to 175 MHz with only 250 ps jitter plus phase error, which provides on-chip clock synthesis.

The M5C/CB Series offers a large selection of diffused SRAM blocks through the Felix™ Compiler. Felix can generate a variety of word and bit length combinations in synchronous single-and dual-port RAMs.

**Diffused SRAMs.**  
User definable SRAMs configurations are available using Motorola's Felix SRAM compiler. Felix generates several versions of a given SRAM size, each with different performance, gate counts, and physical configurations.



## M5C/CB Series Features

- 0.45  $\mu\text{m}$  effective gate length process, triple-layer metal
- Typical gate delay of 240 ps at 3.3 V (CMND20, FO=2)
- Performance optimized 3.3 V core
- Low power of 1  $\mu\text{W}$ /gate/MHz at 3.3 V
- Multiple VDD rails for the core and 3.3 V outputs
- Cell library optimized for efficient logic synthesis
- Single-, and dual-port metal and diffused SRAM compilers
- Contact programmable ROM compiler
- Internal macros characterized from 1.4 to 3.6 volts
- High-speed SCI-LVDS, GTL, PCI and PECL interface macros
- Full support of DFT and SCAN methodology; JTAG/Boundary Scan embedded in periphery
- Clock tree synthesis with clock skew management through optional embedded analog PLL macro functions for clocks up to 175 MHz at 3.3 V with a 50% duty cycle
- Powerful design environment using Mentor Graphics, Synopsys, Cadence Design Systems, Viewlogic, and Motorola's design tools
- Advanced plastic - BGA, Tape Ball Grid Array (TBGA), MQUAD, thermally enhanced QFP and PQFP packaging

M5C Series Features	Available Gates	No. of Die Pads		I/O Cells	Package Pins
M5C078	77,763	188	196	128-160	
M5C112	112,908	224	240	160-208	
M5C142	142,572	248	272	160-225	
M5C208	207,507	292	324	208-225	
M5C252	252,300	320	368	208-313	
M5C307	307,200	348	408	208-313	
M5C380	380,200	388	456	208-352	
M5C460	460,992	424	504	208-420	
M5C557	557,283	460	556	313-420	

**0.5 Micron CMOS Process**

M5CB Series Features	Available Gates	No. of Die Pads		I/O Cells	Package Pins
M5CB183	47,000	160	144	80-160	
M5CB215	69,000	192	176	80-225	
M5CB247	94,000	224	208	80-225	
M5CB278	122,000	256	240	80-225	
M5CB303	147,000	280	284	80-256	
M5CB325	171,000	300	284	80-256	
M5CB347	197,000	324	308	100-313	
M5CB375	231,000	352	336	100-313	
M5CB403	268,000	380	364	144-313	
M5CB441	323,000	420	404	144-420	
M5CB476	377,000	452	436	144-420	
M5CB514	440,000	492	476	225-420	
M5CB554	511,000	532	516	225-420	
M5CB596	591,000	576	560	225-420	



# H4EPlus™ Series Gate Arrays

## Enhanced Density Mixed-Voltage Environments

The H4EPlus Series arrays offer a fully featured 3.3 V, 5 V and mixed-voltage capable family combined with an increased core density providing over 50% more gates in the same die area as Motorola's H4CPlus Series. It offers a wide range of mixed-voltage I/Os, high-speed interfaces, and analog PLLs for clock skew management. The gate length of 0.65  $\mu\text{m}$  nominal Leff provides a competitive 3.3 V performance, with increased performance at 5 V.

The low- and mixed-voltage capability allows designers to customize the H4EPlus arrays to fit power and performance needs. All H4EPlus arrays have dual VDD rails, with custom power/ground tying, to provide full 3.3 V, 5 V and mixed-voltage I/O capability. Additionally, the core logic may be powered at either 3.3 V or 5 V.

High-speed CMTL™, GTL™, PCI and PECL macros offer enhanced chip-to-chip communication. Motorola's CMTL (Current Mode Transceiver Logic™) have optional internal active termination and support differential clock rates of up to 300+ MHz. GTL, PCI and PECL are available for interfacing to standard logic and RAMs.

Each array can have up to two APLL (Analog Phased Lock Loop) macros with separate APLL power pins for lower noise and phase jitter. No external components are required since the VCO filter is built in. These can be used in applications such as clock synthesis with a worst-case VCO frequency of 70 to 250 MHz.

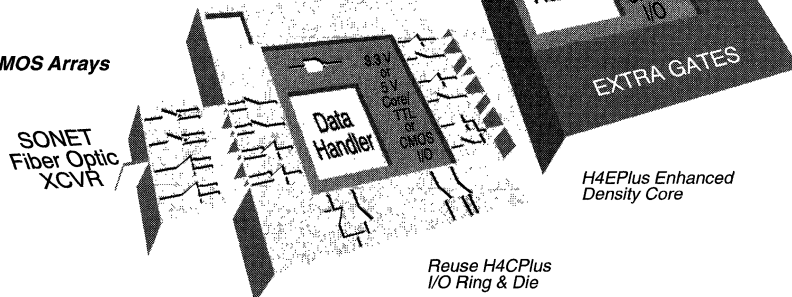
## H4EPlus Series Features

- 0.65  $\mu\text{m}$  Leff, channelless, triple-layer metal gate arrays
- 8,056 to 278,304 available gates
- Typical gate delay of 280 ps at 5 V and 420 ps at 3.3 V (NAN2, FO=2)
- Low power, 1  $\mu\text{W}$ /gate/MHz (3.3 V), 3  $\mu\text{W}$ /gate/MHz (5 V)
- 3.3 V, 5 V or mixed system and core voltage levels
- Custom power bus tying and ground bus isolation for special power needs
- Configurable I/O cell supports 2 to 24 mA, up to 48 mA using dual I/O cells
- PCI compliant 5 V and 3.3 V I/O buffers (5 V tolerant), 3 V I/O macros, and 5 V I/O fail-safe macros
- Differential and single-ended GTL I/O and PECL input macros
- Analog PLL with 70 to 250 MHz worst-case VCO frequency
- DFT methodology support (JTAG, BIST, LSSD, and ESSD)
- JTAG 1149.1 boundary scan built into I/O macros
- Single-, dual-, and quad-port metal SRAMs at 3.3 V and 5 V
- Single-, and dual-port diffused SRAMs
- Powerful design environment using Mentor Graphics, Cadence Design Systems, Synopsys, Quad Design Technology, and Motorola design tools
- GTPAC™ ball-grid array, Thin QFP, Thermally Enhanced QFP, PLCC, and Ceramic BGA packaging

H4EPlus Series Features	Available Gates	No. of Die Pads	I/O Cells	Package Pins
H4EP008	8,056	88	88	44-84
H4EP012	12,220	104	84	44-100
H4EP017	17,316	120	100	44-144
H4EP028	28,600	148	128	68-196
H4EP044	44,500	176	160	68-169
H4EP444	44,500	180	160	160-196
H4EP075	75,168	216	208	80-225
H4EP116	116,756	256	256	128-256
H4EP171	171,500	304	312	160-324
H4EP227	227,232	344	360	160-324
H4EP278	278,304	376	400	160-324

**H4EPlus provides  
50% more gates  
than equivalent  
H4CPlus die size**

### 0.65 Micron CMOS Arrays



# Literature

To order any literature item(s), contact the Motorola Semiconductor Products Literature Center at 1-800-441-2447

## Design Manuals

Order Number	Description
H4EPDM/D	H4EPlus Series CMOS Arrays
M5CDM/D	M5C Series CMOS Arrays

## Data Sheets

H4EP/D	H4EPlus Series CMOS Arrays
M5C/D	M5C Series CMOS Arrays
M5CB/D	M5CB Series Standard Cells

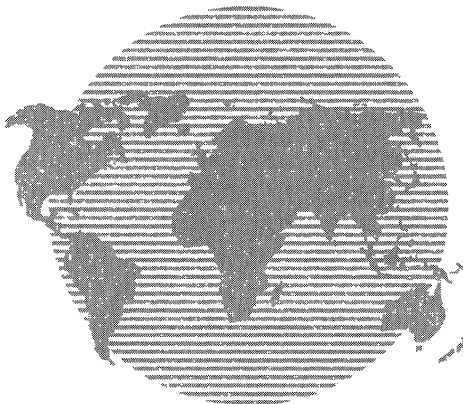
## Brochures/Selector Guides/Misc.

BR916/D	Packaging Manual for ASIC Arrays
BR1441/D	ASIC Reliability and Quality Report
BR1473/D	The Individual Solution

## Application Notes/Article Reprints

Order Number	Description
AN1093/D	Delay and Timing Methods for CMOS and ASICs
AN1500/D	JTAG Boundary Scan for H4C Arrays
AN1502/D	Embedded RAM/BIST
AN1509/D	ASIC Clock Distribution Using PLL
AN1512/D	TestPAS Primer
AN1521/D	High-Performance CMOS Interfaces
AN1522/D	Analog Phase-Locked Loop for H4EPlus and M5C Series Arrays
AN1534/D	Design Considerations of Plastic Ball-Grid Arrays for CMOS Gate Arrays
AN1553/D	Minimizing Skew in Gate Arrays
AN1554/D	SRAM Built-in-Self Test
AR518/D	Gate Arrays Simplify Translation Between High Speed Logic Families
AR524/D	Pick the Right ASIC Package
AR611/D	Exploit the Potential of High-Performance CMOS by Selecting the Best Interface

## Worldwide Design Centers



### ADCD Regional Design Centers - U.S.A.

California, San Jose (408) 991-7331  
Georgia, Atlanta (404) 729-7137  
Illinois, Chicago (847) 413-2526  
Massachusetts, Marlborough (617) 932-6084

### Optimum Design, Service and Support

Motorola has established a worldwide network of ADC design centers to serve the design and applications needs of its customers. The centers provide support at all phases of your semi-custom design. Skilled designers provide training for Motorola's ADC design flows, as well as applications support for CAD and silicon issues during the design process.

### ADCD Regional Design Centers - International

European Headquarters, Germany, Munich  
(089) 92103-306  
England, Aylesbury, Bucks (01296) 395252  
France, Velizy (01) 34635900  
Holland, Best (04998) 61211  
Israel, Tel Aviv (09) 590-303  
Italy, Milan (02) 82201  
Sweden, Stockholm (08) 734-8800  
  
Hong Kong, Silicon Harbour Center, Tai Po  
(852) 2666-8333  
Japan, Tokyo (03) 440-3311

# Microcomputer Components

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## In Brief . . .

Motorola continues to be a leading supplier of components for microcomputer systems. The product portfolio includes digital signal processors; CISC and RISC and PowerPC advanced microprocessors and complementary full-function peripherals; a comprehensive selection of high-performance microcontrollers; VLSI functions for Local Operating Network applications; and a broad range of fast static RAM and dynamic RAM chips and modules.

Our commitment is to provide state-of-the-art devices as well as continuing support of established products, with six-sigma quality and total customer satisfaction.

	<b>Page</b>
Digital Signal Processors . . . . .	2.1-1
The M68000 Family . . . . .	2.2-1
The M88000 RISC Family . . . . .	2.3-1
The PowerPC RISC Family Microprocessors . . . . .	2.4-1
Single-Chip Microcontrollers (CSIC) . . . . .	2.5-1
Single-Chip Microcontrollers (AMCU) . . . . .	2.6-1
LonWorks Products . . . . .	2.7-1
Memory Products . . . . .	2.8-1



# Digital Signal Processors

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## In Brief . . .

Drawing on both design excellence and expertise in manufacturing, Motorola has created a range of architecturally compatible Digital Signal Processing chips. The philosophy behind the DSP families has been to create compatibility between products, as well as to conform to international standards.

Motorola offers a complete portfolio of 16- and 24-bit fixed point and 32-bit floating point DSPs.

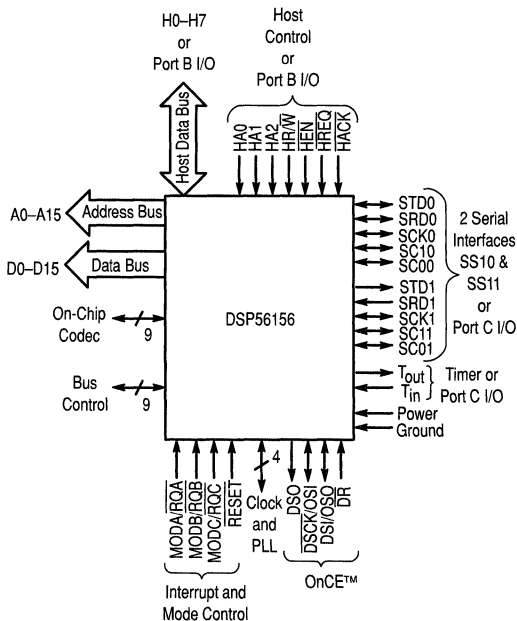
In addition, we offer a comprehensive array of development tools to give the designer access to the full power and versatility of the DSPs with minimum fuss. All the tools were designed for ease of use and functionality. They provide a low-cost means of evaluation and greatly simplify the design and development phase of a DSP project.

	<b>Page</b>
DSP56100—16-Bit Digital Signal Processors . . . .	2.1–2
DSP56800—16-Bit Digital Signal Processors . . . .	2.1–3
DSP56000—24-Bit Digital Signal Processors . . . .	2.1–3
DSP56300—24-Bit Digital Signal Processors . . . .	2.1–5
DSP56600—16-Bit Digital Signal Processors . . . .	2.1–12
DSP96002—32-Bit Digital Signal Processors . . . .	2.1–17
DSP56ADC16—The Analog-To-Digital Converter . . . . .	2.1–18
DSP Development Tools . . . . .	2.1–18
Application Development Systems . . . . .	2.1–18
Graphical User Interface . . . . .	2.1–19
DSP Development Software . . . . .	2.1–19
Design-In Software Packages . . . . .	2.1–19
C Compiler Packages . . . . .	2.1–20
C Compiler Upgrades . . . . .	2.1–20

# 16-/24-/32-Bit Families—Your Complete DSP Solution

## DSP56100—16-Bit Digital Signal Processors

The DSP56100 family of HCMOS, low-power, 16-bit fixed point general-purpose Digital Signal Processors (DSPs) is ideal for high end speech coding, telecommunications, and control applications. The first DSP56100 family member, the DSP56156, combines the high-speed core with 8 K bytes RAM, two serial ports, one parallel port, codec, Phase-Lock Loop (PLL), and an On-Chip Emulation port (OnCE™). The DSP56166, the second member of the DSP56100 family, has identical package and pinout to the DSP56156 with different memory configuration and peripherals.



### PART NUMBERS

Part	Description
XC56156FV40	40 MHz in TQFP
XC56156FV50	50 MHz in TQFP
XC56156FE60	60 MHz in CQFP
XC56166FV60	60 MHz in TQFP

### DSP56156 BENCHMARKS

Benchmark	Instruction Cycles
Real FIR Filter with Data Shift	1 per Tap
LMS Adaptive Real FIR Filter	2 per Tap
Double Integration Sinewave Generation	2 per Sample
Complex FIR Filter with Data Shift	4 per Tap
General Lattice Filter	4 per Tap
Real Cascaded IIR Biquad Filter Sections (4 coeff.)	5 per Section
PID Loop	5
Double Precision Multiply	6
[1 × 3][3 × 3] Matrix Multiplication	21

### DSP56100 Features

- Up to 30 Million Instructions Per Second (MIPS) at 60 MHz; 33.3 ns Instruction cycle
- Single-cycle 16 x 16-bit parallel Multiply-Accumulate
- 2 x 40-bit accumulators with extension byte
- Fractional and integer arithmetic with support for multiprecision arithmetic
- Highly parallel instruction set with unique DSP addressing modes
- Nested hardware DO loops, including infinite loops and DO zero loop
- Two instruction LMS adaptive filter loop
- Fast auto-return interrupts
- Three external interrupt request pins
- Three 16-bit internal data and three 16-bit internal address buses
- Individual programmable wait states on the external bus for program, data, and peripheral memory spaces
- Off-chip memory-mapped peripheral space with programmable access time and separate peripheral enable pin
- On-chip memory-mapped peripheral registers
- Low power Wait and Stop modes
- OnCE port for unobtrusive, processor speed independent debugging
- Operating frequency down to DC
- 5 V single power supply
- Low power (HCMOS)

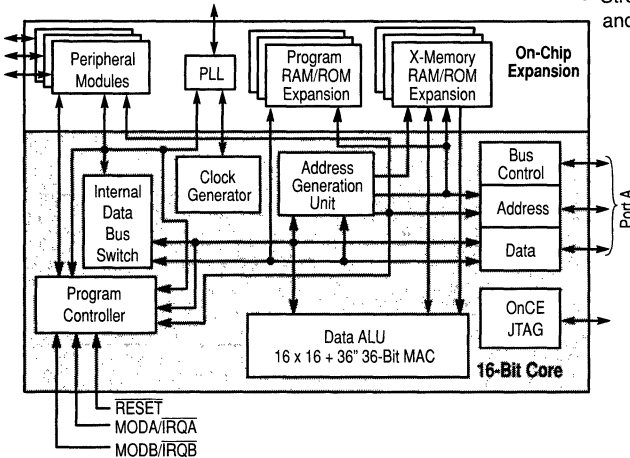
## DSP56800—16-Bit Digital Signal Processors

The DSP56800 core family is the first architecture designed to enable digital signal processing and embedded microcontroller functionality. This multi-functional approach supports applications requiring both signal processing and control functionality, such as wireless messaging, digital answering machines, feature phones, and low-cost wireline modems.

The first two DSP56800 family members, the DSP56L811 and DSP56L812 are identical except for memory configuration. The DSP56L811 contains 1 K of Program RAM and 2 K of data RAM. The DSP56L812 features 22 K of Program ROM, 2 K of data ROM and 2 K of data RAM.

### DSP56800 Features

- 20 MIPS at 40 MHz
- 3.3 volts
- Three 16-bit timers
- Two Serial Peripheral Interfaces (SPIs)
- Serial Synchronous Interface (SSI)
- JTAG OnCE™ Port
- Phase-Lock Loop
- Sixteen – thirty-two general purpose input/output pins. (Sixteen dedicated and sixteen shared with peripherals)
- External bus interface to allow for additional memory
- Support for high-level C and C++ programming languages
- Streamlined instruction set featuring frequently used DSP and microcontroller codes, as well as control extensions



### PART NUMBERS (4Q '96 Availability)

Part	Description
XC56L811BU40	40 MHz in TQFP
XC56L812BU40	40 MHz in TQFP

## DSP56000—24-Bit Digital Signal Processors

The DSP56000 family of 24-bit, fixed point, general purpose Digital Signal Processors is Motorola's original DSP family and has set the standard for high end DSP devices with its triple Harvard architecture of seven internal buses and three parallel execution units—Data ALU, Address Generation Unit, and Program Controller. Motorola has retained architectural compatibility with the 24-bit family into the 16-bit DSP56100 and 32-bit DSP96002 products helping to preserve our customer software investment.

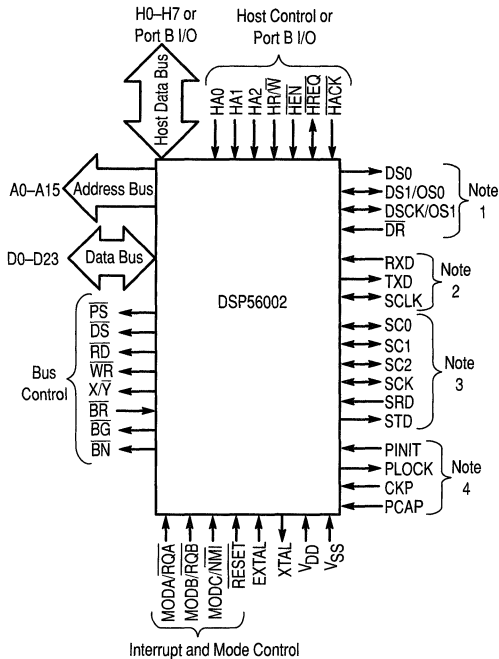
The DSP56000 family of HCMOS, 24-bit DSP devices consists of the DSP56002, DSP56L002, DSP56004, DSP56005, DSP56007, DSP56L007, DSP56009, and the transitional DSP56001A. All these products are source code compatible and are used extensively in telecommunications, control, and audio applications. The DSP56000 family's unique 24-bit architecture has made these products the industry standard for CD-quality digital audio processing.

The DSP56L002 and DSP56L007 low-voltage devices operate at 3.3 volts, which effectively extends the battery life of portable applications up to three times longer than 5 volt systems.

### DSP56002 BENCHMARKS

Benchmark	Instruction Cycles
Real FIR Filter with Data Shift	1 per Tap
Two Dimensional Convolution (3 x 3 coeff. mask)	1 per Output
LMS Adaptive Real FIR Filter	3 per Tap
Real Cascaded IIR Biquad Filter Sections (4 coeff.)	4 per Section
Complex FIR Filter with Data Shift	4 per Tap
[1 x 3][3 x 3] Matrix Multiplication	17
Division	28
Leroux-Gueguen LPC Analysis:	
8th Order	473
10th Order	622
16th Order	1203

## DSP56000—24-Bit Digital Signal Processors (continued)



### NOTES:

1. On-Chip Emulation port (OnCE™)
2. SCI Serial or Port C I/O
3. SSI Serial or Port C I/O
4. Phase Lock Loop (PLL)

### DSP56000 Family Features

- On-chip Harvard architecture permitting simultaneous accesses to program and two data memories
- Two 56-bit accumulators including extension byte
- Parallel 24 x 24-bit multiply-accumulate (MAC) in 1 instruction cycle (2 clock cycles)
- Double precision 48 x 48-bit multiply with 96-bit result in 6 instruction cycles
- 56-bit addition/subtraction in 1 instruction cycle
- Fractional arithmetic with support for multiprecision arithmetic
- Hardware support for block-floating point FFT
- Hardware nested DO loops
- Zero-overhead fast interrupts (2 instruction cycles)
- On-Chip Emulation (OnCE) port for unobtrusive, processor speed-independent debugging
- Software-programmable, Phase Lock Loop (PLL) based frequency synthesizer for the core clock
- On-chip peripheral registers memory mapped in data memory space

- Double-buffered peripherals
- Power-saving Wait and Stop modes

### DSP56002 Features

- 512 x 24-bit on-chip Program RAM and 64 x 24-bit bootstrap ROM
- Two 256 x 24-bit on-chip data RAMs
- Two 256 x 24-bit on-chip data ROMs containing sine, A-law, and  $\mu$ -law tables
- External memory expansion with 16-bit address and 24-bit data buses
- Bootstrap loading from external data bus, Host Interface (HI), or Serial Communication Interface (SCI)
- Byte-wide HI with Direct Memory Access (DMA) support
- Synchronous Serial Interface (SSI) to communicate with codecs and synchronous serial devices
  - 8-, 12-, 16-, 24-bit word sizes
  - Up to 32 software-selectable time slots in network mode
  - SCI for full-duplex asynchronous communications
  - 24-bit Timer/Event Counter also generates and measures digital waveforms
  - Up to twenty-five General Purpose Input/Output (GPIO) pins
  - Three external interrupt request pins; one non-maskable
  - 3.3 V (DSP56L002) and 5 V (DSP56002) power supply options

### DSP56004/DSP56007 Features

- Serial Audio Interface (SAI) includes 2 receivers and 3 transmitters, master or slave capability, and implementation of I<sup>2</sup>S, Sony, and Matshushita audio protocols; two sets of SAI interrupt vectors
- Serial Host Interface (SHI) features single master capability, 10-word receive FIFO, and support for 8-, 16-, and 24-bit words
- External Memory Interface (EMI) peripheral providing glueless connection to DRAM, SRAM, and/or EPROM for audio delay buffering
- Four dedicated, independent, programmable GPIO lines
- DSP56004 memory: 512 words Program RAM, 2 x 256 words data RAM, 2 x 256 words data ROM
- DSP56007 memory: 6400 words Program ROM, 3200 words data RAM, 1024 words data ROM
- 3.3 V power supply option available (DSP56L007)
- Bootstrap loading via I<sup>2</sup>C, SPI, or byte-wide memory modes available
- Up to twenty-five GPIO pins



## DSP56000—24-Bit Digital Signal Processors (continued)

### DSP56005 Features

- Five Pulse Width Modulators (PWM)
- 24-bit timer/event counter also generates and measures digital waveforms
  - Three with alternate outputs; two with open drain or TTL outputs
  - 9-bit to 16-bit data width
  - Alternate outputs independently selectable as active high or active low
- 16-bit Watchdog timer
- 4608 x 24-bit on-chip Program RAM and 96 x 24-bit bootstrap ROM
- Two 256 x 24-bit on-chip data RAMs
- Two 256 x 24-bit on-chip data ROMs, containing sine and arc-tangent tables
- External memory expansion with 16-bit address and 24-bit data buses
- Bootstrap loading from external data bus, Host Interface, or Serial Communication Interface

### DSP56009 Features

The memory configurations available differentiate this DSP from the other family members. The DSP core is fed by a large Program ROM, two independent data RAMs, two data ROMs, a Serial Audio Interface, Serial Host Interface, External Memory Interface, dedicated I/O lines, on-chip Phase Lock Loop (PLL), and On-Chip Emulation (OnCE™) port.

- Completely pin compatible with DSP56004 and DSP56007 for easy upgrades
- 5 V power supply
- On-chip Harvard architecture permitting simultaneous accesses to program and two data memories
- 10240 x 24-bit on-chip Program ROM\*
- 4608 x 24-bit on-chip X data RAM and 3072 x 24-bit on-chip X data ROM\*
- 4352 x 24-bit on-chip Y data RAM and 1792 x 24-bit on-chip Y data ROM\*
- 512 x 24-bit on-chip Program RAM and 64 x 24-bit bootstrap ROM
- Up to 2304 x 24-bit from X and Y data RAM can be switched to Program RAM giving a total of 2816 x 24 bits of Program RAM

- Bootstrap loading from Serial Host Interface or External Memory Interface

\*These ROMs may be factory programmed with data/program provided by the application developer.

### PART NUMBERS

Part	Description
XC56001ARC27	Transitional Device; DSP56002 recommended for new designs
XC56001ARC33	Transitional Device; DSP56002 recommended for new designs
XC56001AFE27	Transitional Device; DSP56002 recommended for new designs
XC56001AFE33	Transitional Device; DSP56002 recommended for new designs
XC56001AFC27	Transitional Device; DSP56002 recommended for new designs
XC56001AFC33	Transitional Device; DSP56002 recommended for new designs
DSP56002RC40	40 MHz RAM-based in 132-pin PGA
DSP56002FC40	40 MHz RAM-based in 132-pin PQFP
DSP56002FC66	66 MHz RAM-based in 132-pin PQFP
XC56002PV40	40 MHz RAM-based in 144-pin TQFP
XC56002PV66	66 MHz RAM-based in 144-pin TQFP
XCP56002PV80	80 MHz RAM-based in 144-pin TQFP
DSP56L002FC40	Low power 40 MHz RAM-based in 132-pin PQFP
XC56L002PV40	Low power 40 MHz RAM-based in 144-pin TQFP
XC56004FJ50	50 MHz RAM-based in 80-pin QFP
XC56004FJ66	66 MHz RAM-based in 80-pin QFP
XC56005PV50	50 MHz RAM-based in 144-pin TQFP
XC56007FJ50	50 MHz ROM-based in 80-pin QFP
XC56007FJ66	66 MHz ROM-based in 80-pin QFP
XC56L007FJ40	Low-power 40 MHz ROM-based in 80-pin QFP
XC56009PV80	80 MHz ROM-based in 80-pin QFP

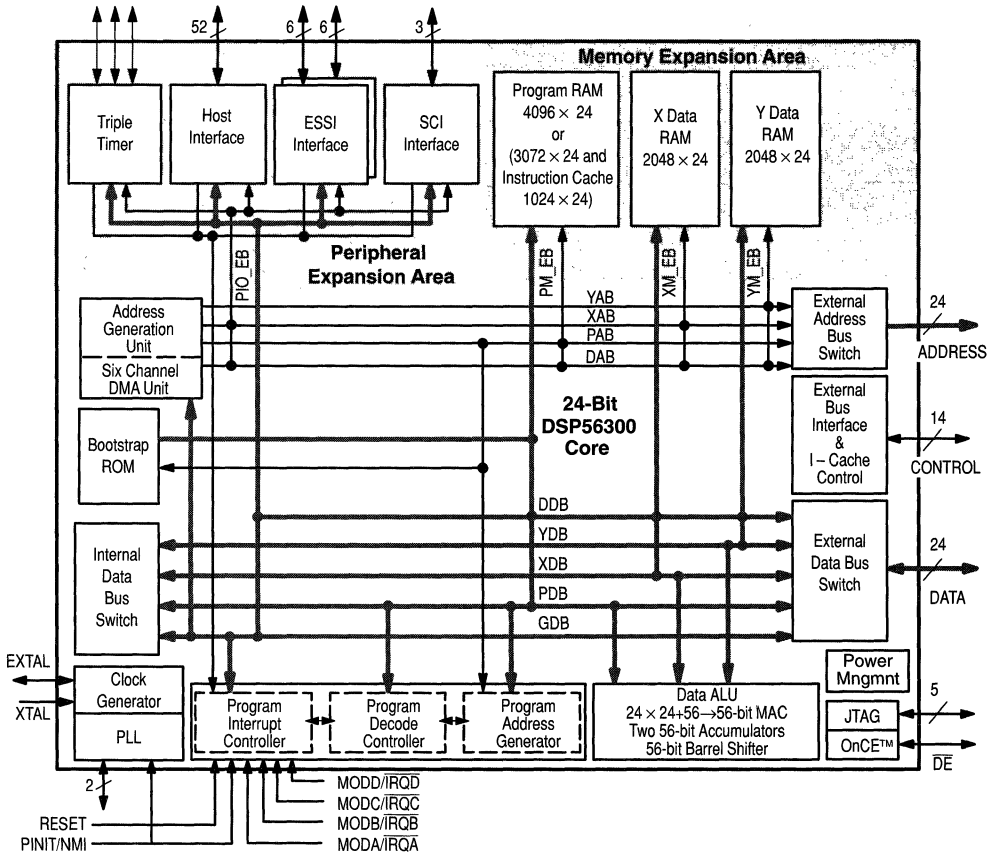
## DSP56300—24-Bit Digital Signal Processors

The first programmable Motorola DSP product to provide a true single-clock-cycle execution, the DSP56300 core effectively doubles the number of instructions executed without increasing clock speed, providing 80 MIPS of performance at 80 MHz, while retaining code compatibility with the rest of the Motorola DSP offerings. The DSP56300 family offers a new level of performance in MIPS, a rich instruction set and low power dissipation, enabling a new generation of products in wireless, telecommunications, and multimedia.

Several significant architectural enhancements include a barrel shifter, 24-bit addressing, instruction cache, and DMA functionality. The DSP56301 offers 66/80 MIPS using an internal 66/80 MHz clock at 3.0–3.6 V.

# DSP56300—24-Bit Digital Signal Processors (continued)

## DSP56301 Features



### High Performance DSP56300 Core

- 66/80 Million Instructions Per Second (MIPS) with a 66/80 MHz clock at 3.3 V
- Object code compatible with the DSP56000 core
- Highly parallel instruction set
- Data Arithmetic Logic Unit (ALU)
  - Fully pipelined 24 × 24-bit parallel Multiplier-Accumulator
  - 56-bit parallel barrel shifter (fast shift and normalization; bit stream generation and parsing)
  - Conditional ALU instructions
  - 24-bit or 16-bit arithmetic support under software control
- Program Control Unit (PCU)
  - Position Independent Code (PIC) support
  - Addressing modes optimized for DSP applications (including immediate offsets)
  - On-chip instruction cache controller
  - On-chip memory-expandable hardware stack
- Nested hardware DO loops
- Fast auto-return interrupts
- Direct Memory Access (DMA)
  - Six DMA channels supporting internal and external accesses
  - One-, two-, and three- dimensional transfers (including circular buffering)
  - End-of-block-transfer interrupts
  - Triggering from interrupt lines and all peripherals
- Phase Lock Loop (PLL)
  - Allows change of low power Divide Factor (DF) without loss of lock
  - Output clock with skew elimination
- Hardware debugging support
  - On-Chip Emulation (OnCE™) module

## DSP56300—24-Bit Digital Signal Processors (continued)

- Joint Action Test Group (JTAG) Test Access Port (TAP) port
- Address tracing mode reflects internal Program RAM accesses at the external port

### On-Chip Memories

- 4096 × 24-bit Program RAM (or, if the cache option is enabled, 1024 × 24-bit Instruction Cache and 3072 × 24-bit Program RAM)
- 2048 × 24-bit X data RAM
- 2048 × 24-bit Y data RAM
- 192 × 24-bit bootstrap ROM

### Off-Chip Memory Expansion

- Data memory expansion to two 16 M × 24-bit word memory spaces
- Program memory expansion to one 16 M × 24-bit words memory space
- External memory expansion port
- Chip Select Logic for glueless interface to SRAMs and SSRAMs
- On-chip DRAM Controller for glueless interface to DRAMs

### On-Chip Peripherals

- 32-bit parallel PCI/Universal Host Interface (HI32), PCI Rev. 2.1 compliant with glueless interface to other DSP563xx buses
- ISA interface requires only 74LS45-style buffer
- Two Enhanced Synchronous Serial Interfaces (ESSI)
- Serial Communications Interface (SCI) with baud rate generator
- Triple timer module

- Up to forty-two programmable General Purpose Input/Output pins (GPIO), depending on which peripherals are enabled

### Reduced Power Dissipation

- Very low power CMOS design
- Wait and Stop low power standby modes
- Fully-static logic, operation frequency down to 0 Hz (DC)
- Optimized power management circuitry (instruction-dependent, peripheral-dependent, and mode-dependent)

### Target Applications

The DSP56301 is intended for general-purpose digital signal processing, particularly in multimedia and telecommunication applications, such as videoconferencing and cellular telephony.

### Product Documentation

The three documents listed in the following table are required for a complete description of the DSP56301 and are necessary to design properly with the part. Documentation is available from one of the following locations (see back cover for detailed information):

- A local Motorola distributor
- A Motorola semiconductor sales office
- A Motorola Literature Distribution Center
- The World Wide Web (WWW)

See the **Additional Support** section of the *DSP56300 Family Manual* for detailed information on the multiple support options available to you.

### DSP56301 DOCUMENTATION

Name	Description	Order Number
DSP56300 Family Manual	Detailed description of the DSP56300 family processor core and instruction set	DSP56300FM/AD
DSP56301 User's Manual	Detailed functional description of the DSP56301 memory configuration, operation, and register programming	DSP56301UM/AD
DSP56301 Technical Data	DSP56301 features list and physical, electrical, timing, and package specifications	DSP56301/D

### Ordering Product

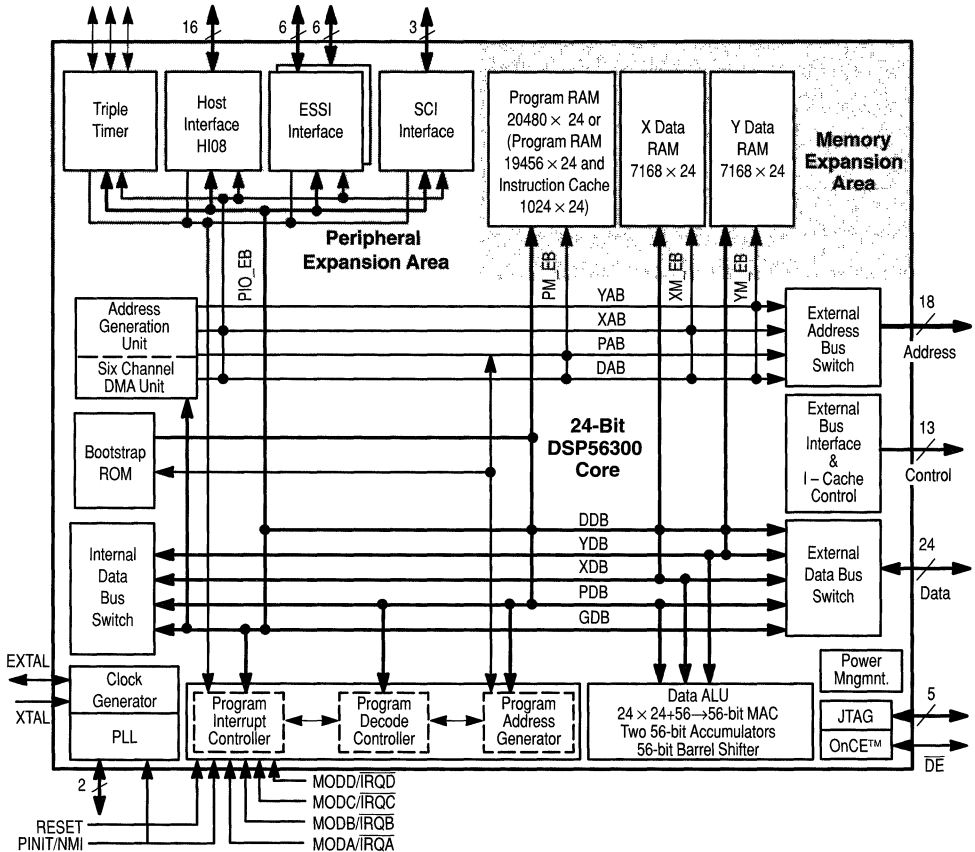
Consult a Motorola Semiconductor sales office or authorized distributor to determine product availability and to place an order.

### ORDERING INFORMATION

Part	Supply Voltage	Package Type	Pin Count	Frequency (MHz)	Order Number
DSP56301	3 V	Thin Quad Flat Pack (TQFP)	208	66	DSP56301PW66
DSP56301	3 V	Thin Quad Flat Pack (TQFP)	208	80	DSP56301PW80
DSP56301	3 V	Plastic Ball Grid Array (PBGA)	252	66	DSP56301GC66
DSP56301	3 V	Plastic Ball Grid Array (PBGA)	252	80	DSP56301GC80

# DSP56300—24-Bit Digital Signal Processors (continued)

## DSP56302 Features



### High Performance DSP56300 Core

- 66 Million Instructions Per Second (MIPS) with a 66 MHz clock
- Object code compatible with the DSP56000 core
- Highly parallel instruction set
- Data Arithmetic Logic Unit (ALU)
  - Fully pipelined 24 x 24-bit parallel multiplier-accumulator
  - 56-bit parallel barrel shifter (fast shift and normalization; bit stream generation and parsing)
  - Conditional ALU instructions
  - 24-bit or 16-bit arithmetic support under software control
- Program Control Unit (PCU)
  - Position Independent Code (PIC) support
  - Addressing modes optimized for DSP applications (including immediate offsets)
  - On-chip instruction cache controller
  - On-chip memory-expandable hardware stack
- Nested hardware DO loops
- Fast auto-return interrupts
- Direct Memory Access (DMA)
  - Six DMA channels supporting internal and external accesses
  - One-, two-, and three-dimensional transfers (including circular buffering)
  - End-of-block-transfer interrupts
  - Triggering from interrupt lines and all peripherals
- Phase Lock Loop (PLL)
  - Allows change of low power Divide Factor (DF) without loss of lock
  - Output clock with skew elimination

## DSP56300—24-Bit Digital Signal Processors (continued)

- Hardware debugging support
  - On-Chip Emulation (OnCE™) module
  - Joint Action Test Group (JTAG) Test Access Port (TAP) port
  - Address tracing mode reflects internal accesses at the external port

### On-Chip Memories

- Program RAM, Instruction Cache, X data RAM, and Y data RAM size is programmable

Instruction Cache	Switch Mode	Program RAM Size	Instruction Cache Size	X Data RAM Size	Y Data RAM Size
disabled	disabled	20480 × 24-bit	0	7168 × 24-bit	7168 × 24-bit
enabled	disabled	19456 × 24-bit	1024 × 24-bit	7168 × 24-bit	7168 × 24-bit
disabled	enabled	24576 × 24-bit	0	5120 × 24-bit	5120 × 24-bit
enabled	enabled	23552 × 24-bit	1024 × 24-bit	5120 × 24-bit	5120 × 24-bit

- 192 x 24-bit bootstrap ROM

### Off-Chip Memory Expansion

- Data memory expansion to two 256 K x 24-bit word memory spaces
- Program memory expansion to one 256 K x 24-bit words memory space
- External memory expansion port
- Chip Select Logic for glueless interface to SRAMs and SSRAMs
- On-chip DRAM Controller for glueless interface to DRAMs

### On-Chip Peripherals

- Enhanced DSP56000-like 8-bit parallel Host Interface (HI08) supports a variety of buses (e.g., ISA) and provides glueless connection to a number of industry standard microcomputers, microprocessors, and DSPs
- Two Enhanced Synchronous Serial Interfaces (ESSI), each with one receiver and three transmitters (allows six-channel home theater)
- Serial Communications Interface (SCI) with baud rate generator
- Triple timer module
- Up to thirty-four programmable General Purpose Input/Output (GPIO) pins, depending on which peripherals are enabled

### Reduced Power Dissipation

- Very low power CMOS design
- Wait and Stop low power standby modes
- Fully-static logic, operation frequency down to 0 Hz (DC)
- Optimized power management circuitry (instruction-dependent, peripheral-dependent, and mode-dependent)

### Target Applications

The DSP56302 is intended for applications requiring a large amount of on-chip memory, such as wireless infrastructure applications. It is also intended as a RAM-based emulation part for low-cost ROM-based solutions.

### Product Documentation

The three documents listed in the following table are required for a complete description of the DSP56302 and are necessary to design properly with the part. Documentation is available from one of the following locations (see back cover for detailed information):

- A local Motorola distributor
- A Motorola semiconductor sales office
- A Motorola Literature Distribution Center
- The World Wide Web (WWW)

See the **Additional Support** section of the *DSP56300 Family Manual* for detailed information on the multiple support options available to you.

### DSP56302 DOCUMENTATION

Name	Description	Order Number
DSP56300 Family Manual	Detailed description of the DSP56300 family processor core and instruction set	DSP56300FM/AD
DSP56302 User's Manual	Detailed functional description of the DSP56302 memory configuration, operation, and register programming	DSP56302UM/AD
DSP56302 Technical Data	DSP56302 features list and physical, electrical, timing, and package specifications	DSP56302/D

# DSP56300—24-Bit Digital Signal Processors (continued)

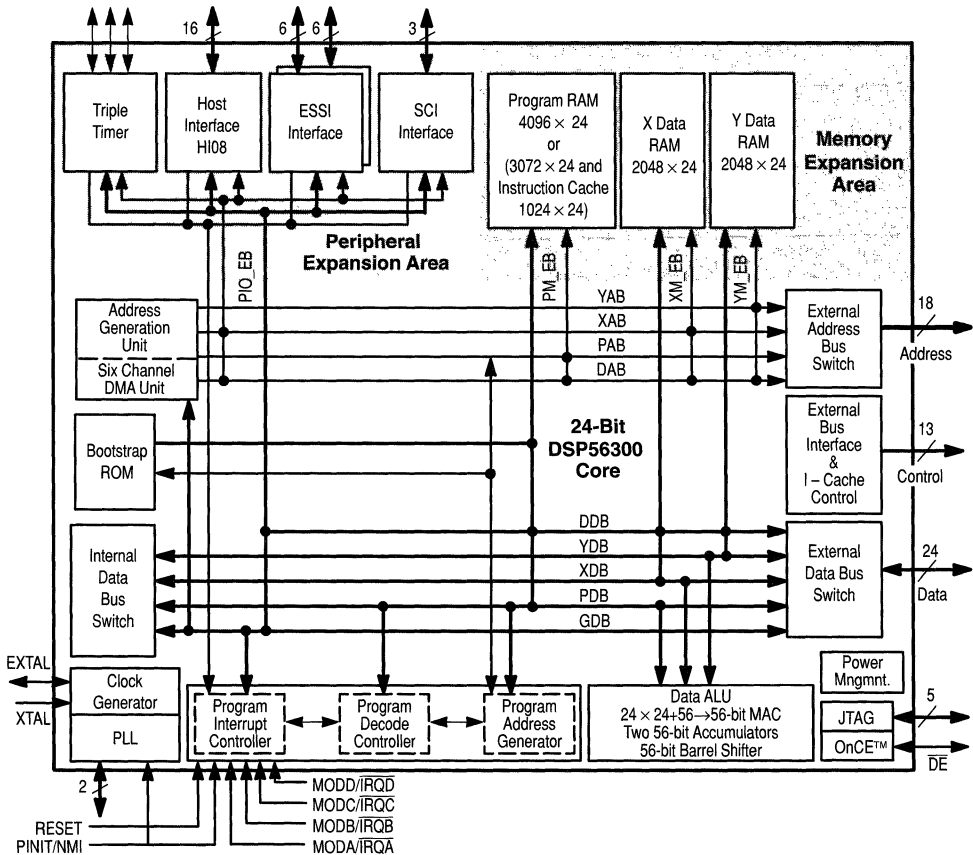
## Ordering Product

Consult a Motorola Semiconductor sales office or authorized distributor to determine product availability and to place an order.

### ORDERING INFORMATION

Part	Supply Voltage	Package Type	Pin Count	Frequency (MHz)	Order Number
DSP56302	3 V	Thin Quad Flat Pack (TQFP)	144	66	DSP56302PV66

## DSP56303 Features



### High Performance DSP56300 Core

- 66/80 Million Instructions Per Second (MIPS) with a 66/80 MHz clock at 3.3 V
- Object code compatible with the DSP56000 core
- Highly parallel instruction set
- Data Arithmetic Logic Unit (ALU)
  - Fully pipelined 24 x 24-bit parallel multiplier-accumulator

- 56-bit parallel barrel shifter (fast shift and normalization; bit stream generation and parsing)
- Conditional ALU instructions

## DSP56300—24-Bit Digital Signal Processors (continued)

- 24-bit or 16-bit arithmetic support under software control
- Program Control Unit (PCU)
  - Position Independent Code (PIC) support
  - Addressing modes optimized for DSP applications (including immediate offsets)
  - On-chip instruction cache controller
  - On-chip memory-expandable hardware stack
  - Nested hardware DO loops
  - Fast auto-return interrupts
- Direct Memory Access (DMA)
  - Six DMA channels supporting internal and external accesses
  - One-, two-, and three-dimensional transfers (including circular buffering)
  - End-of-block-transfer interrupts
- Triggering from interrupt lines and all peripherals
- Phase Lock Loop (PLL)
  - Allows change of low power Divide Factor (DF) without loss of lock
  - Output clock with skew elimination
- Hardware debugging support
  - On-Chip Emulation (OnCE™) module
  - Joint Action Test Group (JTAG) Test Access Port (TAP)
  - Address tracing mode reflects internal Program RAM accesses at the external port

### On-Chip Memories

- Program RAM, Instruction Cache, X data RAM, and Y data RAM size is programmable:

Instruction Cache	Switch Mode	Program RAM Size	Instruction Cache Size	X Data RAM Size	Y Data RAM Size
disabled	disabled	4096 × 24-bit	0	2048 × 24-bit	2048 × 24-bit
enabled	disabled	3072 × 24-bit	1024 × 24-bit	2048 × 24-bit	2048 × 24-bit
disabled	enabled	2048 × 24-bit	0	3072 × 24-bit	3072 × 24-bit
enabled	enabled	1024 × 24-bit	1024 × 24-bit	3072 × 24-bit	3072 × 24-bit

- 192 x 24-bit bootstrap ROM

### Off-Chip Memory Expansion

- Data memory expansion to two 256 K x 24-bit word memory spaces
- Program memory expansion to one 256 K x 24-bit words memory space
- External memory expansion port
- Chip Select Logic for glueless interface to SRAMs and SSRAMs
- On-chip DRAM Controller for glueless interface to DRAMs

### On-Chip Peripherals

- Enhanced DSP56000-like 8-bit parallel Host Interface (HI08) supports a variety of buses (e.g., ISA) and provides glueless connection to a number of industry standard microcomputers, microprocessors, and DSPs
- Two Enhanced Synchronous Serial Interfaces (ESSI), each with one receiver and three transmitters (allows six-channel home theater)
- Serial Communications Interface (SCI) with baud rate generator
- Triple timer module
- Up to thirty-four programmable General Purpose Input/Output (GPIO) pins, depending on which peripherals are enabled

### Reduced Power Dissipation

- Very low power CMOS design
- Wait and Stop low power standby modes
- Fully-static logic, operation frequency down to 0 Hz (DC)
- Optimized power management circuitry (instruction-dependent, peripheral-dependent, and mode-dependent)

### Target Applications

The DSP56303 is intended for use in telecommunication applications, such as multi-line voice/data/fax processing, videoconferencing, audio applications, control, and general digital signal processing.

### Product Documentation

The three documents listed in the following table are required for a complete description of the DSP56303 and are necessary to design properly with the part. Documentation is available from one of the following locations (see back cover for detailed information):

- A local Motorola distributor
- A Motorola semiconductor sales office
- A Motorola Literature Distribution Center
- The World Wide Web (WWW)

See the **Additional Support** section of the *DSP56300 Family Manual* for detailed information on the multiple support options available to you.

## DSP56300—24-Bit Digital Signal Processors (continued)

### DSP56303 DOCUMENTATION

Name	Description	Order Number
DSP56300 Family Manual	Detailed description of the DSP56300 family processor core and instruction set	DSP56300FM/AD
DSP56303 User's Manual	Detailed functional description of the DSP56303 memory configuration, operation, and register programming	DSP56303UM/AD
DSP56303 Technical Data	DSP56303 features list and physical, electrical, timing, and package specifications	DSP56303/D

### Ordering Product

Consult a Motorola Semiconductor sales office or authorized distributor to determine product availability and to place an order.

### ORDERING INFORMATION

Part	Supply Voltage	Package Type	Pin Count	Frequency (MHz)	Order Number
DSP56303	3 V	Thin Quad Flat Pack (TQFP)	144	66	DSP56303PV66
DSP56303	3 V	Thin Quad Flat Pack (TQFP)	144	80	DSP56303PV80
DSP56303	3 V	Plastic Ball Grid Array (PBGA)	196	66	DSP56303GC66
DSP56303	3 V	Plastic Ball Grid Array (PBGA)	196	80	DSP56303GC80

## DSP56600—16-Bit Digital Signal Processors

The DSP56600 core can execute one 24-bit instruction per clock cycle using 16-bit data. The 60-MHz chip includes a mixture of peripherals and memories optimized for processing-intensive, yet cost-effective, low power consumption digital mobile communications applications. The DSP56600 core includes the data Arithmetic and Logic Unit (ALU), Address Generation Unit (AGU), program controller, program patch detector, bus interface unit, On-Chip Emulation (OnCE™), JTAG port, and a Phase Lock Loop (PLL)-based clock generator.

### DSP56602 Features

The DSP56602 expansion area includes program and data memories (ROM and RAM), a triple timer module, an 8-bit Host Interface (HI08) port, and two 16-bit Synchronous Serial Interface (SSI) ports. The DSP56602 also provides from three to thirty-four GPIO lines, depending on which user-enabled peripherals are used, and three external dedicated interrupt lines. The DSP56602 is designed specifically for low-power digital handset cellular applications and can perform a wide variety of fixed point digital signal processing algorithms.

### Digital Signal Processing Core

- High-performance 16-bit DSP56600 family DSP engine
- Up to 60 Million Instructions Per Second (MIPS) at 2.7–3.3 V
- Fully pipelined 16 x 16-bit parallel multiply-accumulator

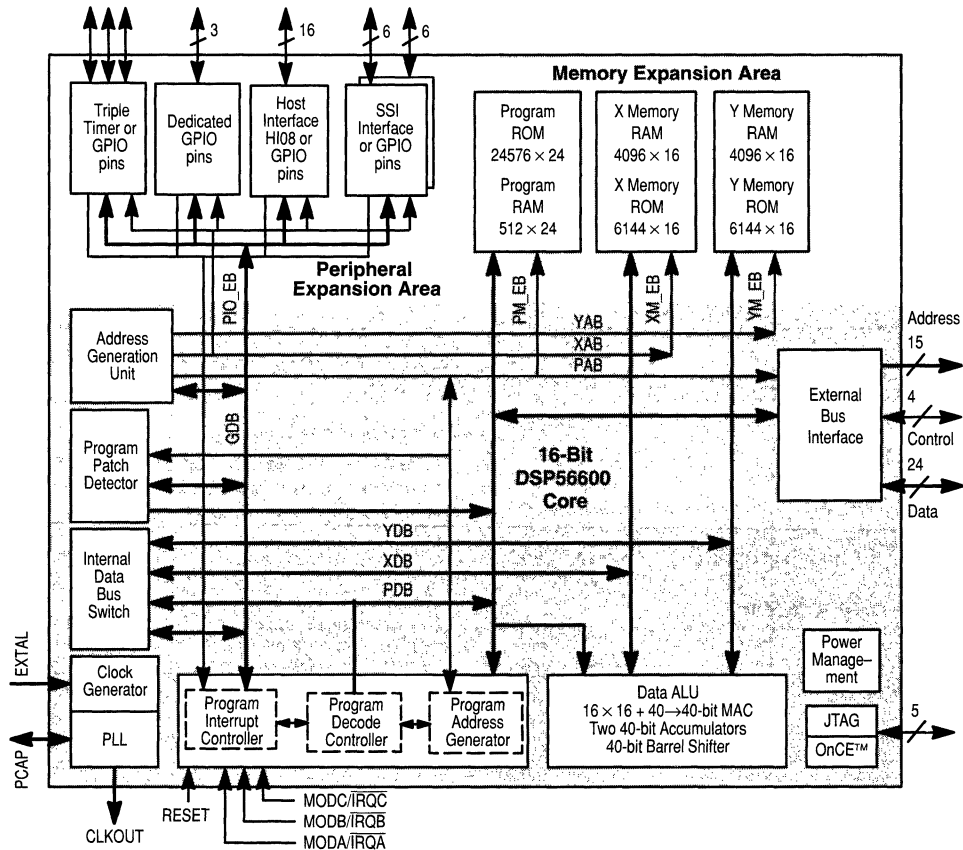
- Two 40-bit accumulators including extension bits
- 40-bit parallel barrel shifter
- Highly parallel instruction set with unique DSP addressing modes
- Code-compatible with the DSP56300 core
- Position-independent code support
- Nested hardware DO loops
- Fast auto-return interrupts
- On-chip support for software patching and enhancements
- On-chip Phase Lock Loop (PLL) circuit
- Real-time trace capability via external address bus
- On-Chip Emulator (OnCE) module
- JTAG port

### Memory

- 512 x 24 Program RAM
- 24 K x 24 Program ROM
- 4 K x 16 X-data RAM
- 6 K x 16 X-data ROM
- 4 K x 16 Y-data RAM
- 6 K x 16 Y-data ROM
- Off-chip expansion of both program and data memories
- Chip-select pin for direct SRAM interface
- Interface to external SRAM memories without additional logic



## DSP56600—16-Bit Digital Signal Processors (continued)



### Peripheral Circuits

- Three dedicated General Purpose Input/Output (GPIO) pins and as many as thirty-one additional GPIO pins (user-selectable as peripherals or GPIO pins)
- Host Interface (HI08) support: one 8-bit parallel port (or as many as sixteen additional GPIO pins)
  - Direct interface to Motorola HC11, Hitachi H8, 8051 family, Thomson P6 family
  - Minimal logic interface to standard ISA bus, Motorola 68K family, and Intel x86 microprocessor family
- Synchronous Serial Interface (SSI) support: two six-pin ports (or twelve additional GPIO pins)
  - Supports serial devices with one or more industry-standard codecs, other DSPs, microprocessors, and Motorola SPI-compliant peripherals
  - Independent transmitter and receiver sections and a common SSI clock generator

- Network mode using frame sync and as many as thirty-two time slots
- 8-bit, 12-bit, and 16-bit data word lengths
- Three programmable timers (or as many as three additional GPIO pins)
- Three external interrupt/mode control lines
- One external reset pin for hardware reset

### Energy Efficient Design

- Operating voltage range: 1.8 V to 3.3 V
- Very low power CMOS design
  - < 0.85 mA/MIPS at 2.7 V
  - < 0.55 mA/MIPS at 1.8 V
- Low-power Wait standby mode
- Ultra-low-power Stop standby mode
- Fully static, HCMOS design for operating frequencies from 60 MHz down to DC
- Special power management circuitry

## DSP56600—16-Bit Digital Signal Processors (continued)

### Product Documentation

The three documents listed in the table below are required for a complete description of the DSP56602 and are necessary to design properly with the part. Documentation is

available from a local Motorola distributor, a Motorola semiconductor sales office, a Motorola Literature Distribution Center, or through the Motorola DSP home page on the Internet (the source for the latest information).

### DSP56602 DOCUMENTATION

Name	Description	Order Number
DSP56600 Family Manual	Detailed description of the 56600-family architecture, and 16-bit DSP core processor and the instruction set	DSP56600FM/AD
DSP56602 User's Manual	Detailed description of memory, peripherals, and interfaces	DSP56602UM/AD
DSP56602 Technical Data	Electrical and timing specifications, pin descriptions, and package descriptions	DSP56602/D

### For the Latest Information

Refer to the back cover of this document for:

- Motorola contact addresses
- Motorola MFAX service
- Motorola DSP Internet address
- Motorola DSP Helpline

The MFAX service and the DSP Internet connection maintain the most current specifications, documents, and

drawings. These two services are available on demand 24 hours a day.

### Ordering Information

The following table lists pertinent information needed to place an order. Consult a Motorola Semiconductor sales office or authorized distributor to determine availability and to order parts.

### ORDERING INFORMATION

Part	Supply Voltage	Package Type	Pin Count	Frequency (MHz)	Order Number
DSP56602	3.0 V	Plastic Thin Quad Flat Pack (TQFP)	144	60	DSP56602PV60
DSP56602	3.0 V	Plastic Ball Grid Array (PBGA)	196	60	DSP56602GC60

### DSP56603 Features

#### Digital Signal Processing Core

- High-performance DSP56600 core
- Up to 60 Million Instructions Per Second (MIPS) at 2.7–3.3 V
- Fully pipelined 16 × 16-bit parallel multiply-accumulator
- Two 40-bit accumulators including extension bits
- 40-bit parallel barrel shifter
- Highly parallel instruction set with unique DSP addressing modes
- Code-compatible with the DSP56300 core
- Position-independent code support
- Nested hardware DO loops
- Fast auto-return interrupts
- On-chip support for software patching and enhancements
- On-chip Phase Lock Loop (PLL) circuit
- Real-time trace capability via external address bus
- On-Chip Emulator (OnCE) module and JTAG port

#### Memory

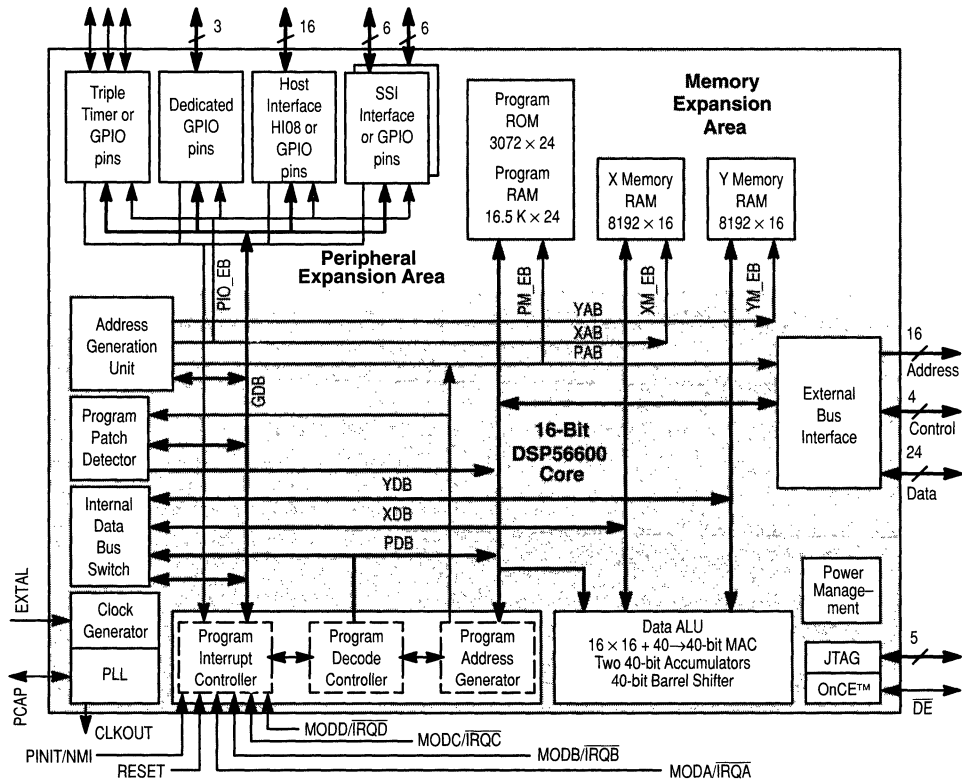
- Switch Mode memory allows reconfiguring program, X-data, and Y-data RAM sizes
  - Switch Mode off
- 16 K × 24-bit program RAM

- 8 K × 16-bit X-data RAM
- 8 K × 16-bit Y-data RAM
  - Switch Mode on
- 11 K × 24-bit program RAM
- 10.5 K × 16-bit X-data RAM
- 10.5 K × 16-bit Y-data RAM
- 3 K × 24-bit program ROM
- Off-chip expansion for both program fetch and program data transfers
- No additional logic needed for interface to external SRAM memories

#### Peripheral Circuits

- Three dedicated General Purpose Input/Output (GPIO) pins and as many as thirty-one additional GPIO pins (user-selectable as peripherals or GPIO pins)
- Host Interface (HI) support: one 8-bit parallel port (or as many as sixteen additional GPIO pins)
  - Direct interface to Motorola HC11, Hitachi H8, 8051 family, Thomson P6 family
  - Minimal logic interface to standard ISA bus, Motorola 68K family, and Intel x86 microprocessor family.

## DSP56600—16-Bit Digital Signal Processors (continued)



- Synchronous Serial Interface (SSI) support: two 6-pin ports (or twelve additional GPIO pins)
  - Supports serial devices with one or more industry-standard codecs, other DSPs, microprocessors, and Motorola SPI-compliant peripherals
  - Independent transmitter and receiver sections and a common SSI clock generator
  - Network mode using frame sync and up to 32 time slots
  - 8-bit, 12-bit, and 16-bit data word lengths
- Three programmable timers (or as many as three additional GPIO pins)

- Three external interrupt/mode control lines
- One external reset pin for hardware reset

### Energy Efficient Design

- Very low power CMOS design
  - Operating voltage range: 1.8 V to 3.3 V
  - < 0.85 mA/MIPS at 2.7 V
  - < 0.55 mA/MIPS at 1.8 V
- Low power Wait for interrupt standby mode, and ultra low power Stop standby mode
- Fully static, HCMOS design for operating frequencies from 60 MHz down to DC
- Special power management circuitry

## DSP56600—16-Bit Digital Signal Processors (continued)

### Product Documentation

The three documents listed in the table below are required for a complete description of the DSP56603 and are necessary to properly design with the part. Documentation is

available from a local Motorola distributor, a Motorola semiconductor sales office, a Motorola Literature Distribution Center, or through the Motorola DSP home page on the Internet (the source for the latest information).

### DSP56602 DOCUMENTATION

Name	Description	Order Number
DSP56600 Family Manual	Detailed description of the 56600-family architecture, and 16-bit DSP core processor and the instruction set	DSP56600FM/AD
DSP56603 User's Manual	Detailed description of memory, peripherals, and interfaces	DSP56603UM/AD
DSP56602 Technical Data	Electrical and timing specifications, pin descriptions, and package descriptions	DSP56602/D

### For the Latest Information

Refer to the back cover of this document for:

- Motorola contact addresses
- Motorola MFAX service
- Motorola DSP Internet address
- Motorola DSP Helpline

The MFAX service and the DSP Internet connection maintain the most current specifications, documents, and

drawings. These two services are available on demand 24 hours a day.

### Ordering Information

The following table lists pertinent information needed to place an order. Consult a Motorola Semiconductor sales office or authorized distributor to determine availability and to order parts.

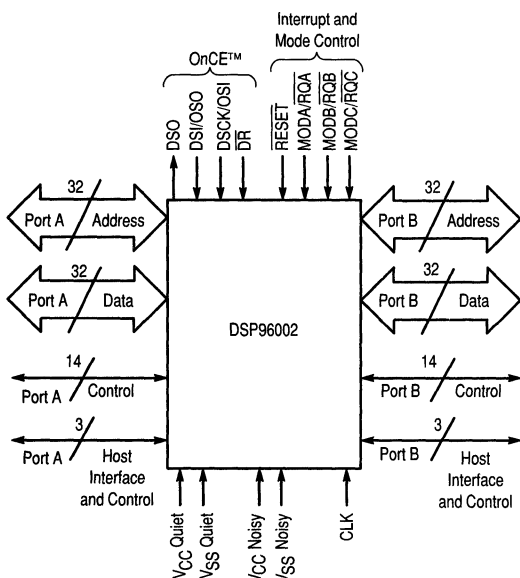
### ORDERING INFORMATION

Part	Supply Voltage	Package Type	Pin Count	Frequency (MHz)	Order Number
DSP56603	3.0 V	Plastic Thin Quad Flat Pack (TQFP)	144	60	DSP56603PV60

# DSP96002—32-Bit Digital Signal Processors

The DSP96002 has full architecture compatibility with the 16-bit DSP56100 and 24-bit DSP56000 families. The DSP96002 is the first in a family of 32-bit IEEE floating point DSP devices. The DSP96002 has two identical memory expansion ports simplifying network configurations for multiprocessor and DSP96002 communications. These ports interface to SRAM, DRAM (operating in their fast access modes), video RAM, or directly to other processors with Host Interface logic.

Although designed primarily for image processing, other proven applications include communications, spectrum analysis, instrumentation, speech processing, and pattern recognition.



## PART NUMBERS

Part	Description
XC96002RC33	33 MHz in PGA
XC96002RC40	40 MHz in PGA

## DSP96002 BENCHMARKS

Benchmark	Instruction Cycles
Real	
FIR Filter with Data Shift $V = V \cdot S + V$	1 per Tap 2
Lattice Filter with Data Shift	3 per Tap
Cascaded IIR Biquad Filter Sections (4 coeff.)	4 per Section
1024-point FFT and bit reversal	12880
Complex	
$V = V \cdot V + V$	4
FIR Filter with Data Shift	4 per Tap
1024-point FFT and bit reversal	20931
Graphics/Image Processing	
Divide (32-bit accuracy)	7
Square Root (32-bit accuracy)	12
Bezier Cubic Evaluation for Font Compilation	13
$[4 \times 4][4 \times 4] = [4 \times 4]$	67

## DSP96002 Features

- DSP96000 family architecture
  - Full IEEE Standard 754 compatible for 32-bit (SP) and 44-bit (SEP) arithmetic
  - 20 MIPS, 50 ns instruction cycle at 40 MHz
  - 60 Million Floating Point Operations Per Second (MFLOPS) at 40 MHz
  - Single cycle  $32 \times 32 \rightarrow 96$ -bit Multiply/Accumulate (MAC)
  - Ten 96-bit general purpose data registers
  - Zero-overhead nested DO loops
  - Two instruction-cycle fast interrupts
  - Low-power Wait and Stop modes
  - On-Chip Emulation port for unobtrusive, full-speed debugging
  - 4 K byte instruction cache
  - Integer mode available
  - Single precision mode available
  - Timer/Event Counter
- DSP96002 peripherals
  - Two 32-bit address and data host ports
  - Dual channel DMA controller
- DSP96002 memories
  - 1024 x 32 Program RAM
  - 2 x 512 x 32 data RAM
  - 2 x 512 x 32 data ROM (sine and cosine tables)

# DSP56ADC16—The Analog-To-Digital Converter

The DSP56ADC16 is a single-chip, linear Analog-to-Digital (A/D) converter. It is an ideal choice for high-performance digital audio systems, voice-bandwidth communication, and control applications. It does not require antialiasing filters and sample-and-hold circuitry because they are an inherent part of the sigma-delta technology. The DSP56ADC16 can be easily interfaced to the DSP56001 and other host processors using its flexible serial interface.

## Key Features

- 16-bit output resolution at 100 kHz from FIR filter
- 12-bit output resolution at 400 kHz from Comb filter
- 96 dB dynamic range
- 90 dB signal-to-THD ratio
- 90 dB signal-to-noise ratio
- In-band ripple: <0.001 dB

- Maximum output sample rates:
  - FIR filter—100 kHz
  - Comb filter—400 kHz
- Maximum input sample rate is 6.4 MHz
- Maximum internal clock rate is 12.8 MHz
- DC stability is 10 bits
- Supply voltage is single +5 V ( $\pm 10\%$ )
- Supply current is < 100 mA
- Linear-phase analog front end and internal digital filters
- Simple serial interface to host microprocessors
- Fully differential inputs

## PART NUMBERS

Part	Description
DSP56ADC16S	16-bit in Ceramic DIP

## DSP Development Tools Application Development Systems

Every member of the Motorola Family of 16-, 24-, and 32-bit DSPs is supported by a multi-component Application Development System (ADS), which acts as a tool for designing, debugging, and evaluating real-time DSP target system equipment. The ADS simplifies evaluation of the user's prototype hardware/software product by making all of the essential timing and I/O circuitry easily accessible. Using an IBM PC™, Macintosh™ II, a Sun-4™, or Hewlett-Packard Series 700 as a medium between the user and the DSP hardware significantly reduces the overall complexity and cost of development while increasing the capabilities of the system. With the ADS, DSP programs can be executed in real-time, single-instruction-traced or multiple-instruction-stepped, with registers and/or memory block contents displayed. The ADS is fully compatible with the CLAS design-in software package for each product and may act as an accelerator for testing DSP algorithms.

All Application Development Systems offer an On-Chip Emulation (OnCE™) circuit for unobtrusive, processor speed independent debugging. The ADS takes full advantage of this circuit to allow the user non-intrusive control of the target.

### General ADS Features

Software—

- Single/multiple stepping through DSP object programs
- Conditional/unconditional software and hardware breakpoints
- Program patching using a single-line assembler/disassembler
- Session and/or command logging for later reference
- Loading and saving of files to/from ADM memory
- Macro command definition and execution
- Display enable/disable of registers and memory
- Debug commands which support multiple DSP development
- Hexadecimal/decimal/binary calculator

- Multiple input/output file access from DSP object programs
- On-line help screens for each command and register

Hardware—

- Full speed operation
- Multiple ADM support with programmable ADM addressing
- Stand-alone operation of ADM after initial development

### DSP56156ADS Features

- System commands from within ADS user interface program
- 16 K words of configurable static RAM expandable to 64 K words

### DSP56002ADS Features

- Host operating system commands from within ADS user interface program
- 8 K/32 K words of configurable RAM for DSP56002 code development
- 96-pin euro-card connector for accessing all DSP56000/1 pins
- 1 K words of monitor ROM expandable to 4 K words
- Separate connectors for accessing serial or host/DMA ports

### DSP96000ADS Features

- System commands from within ADS user interface program
- 128 K words of configurable static RAM expandable to 512 K words
- 2 K words of EPROM with sockets expandable to 64 K words
- Full support of multiple data memory maps
- Two sets of 96-pin connectors provide access to all DSP96002 pins
- 2 K words of EPROM with sockets expandable to 16 K words

## DSP Development Tools (continued)

### PART NUMBERS

Development Systems	Host Machine
DSP56100ADSA *	IBM PC
DSP56100ADSB	Macintosh II
DSP56100ADSF *	Sun-4
DSP56100ADSH *	Hewlett-Packard Series 700
DSP96000ADSA *	IBM PC
DSP96000ADSB	Macintosh II
DSP96000ADSF *	Sun-4
DSP96000ADSH *	Hewlett-Packard Series 700
DSP56002ADSA *	IBM PC
DSP56002ADSB	Macintosh II
DSP56002ADSF *	Sun-4
DSP56002ADSH *	Hewlett-Packard Series 700
DSP56004ADSA *	IBM PC
DSP56004ADSB	Macintosh II
DSP56004ADSF *	Sun-4
DSP56004ADSH *	Hewlett-Packard Series 700
DSP56005ADSA *	IBM PC
DSP56005ADSB	Macintosh II
DSP56005ADSF *	Sun-4
DSP56005ADSH *	Hewlett-Packard Series 700
DSP56005ADPTR	Adapter Board
DSP56301ADSA *	IBM PC
DSP56301ADSF *	Sun-4
DSP56301ADSH *	Hewlett-Packard Series 700
DSP56002ADM	ADM Board for DSP56002
DSP56004ADM	ADM Board for DSP56004
DSP56156ADM	ADM Board for DSP56156
DSP56166ADM	ADM Board for DSP56166
DSP96000ADM	ADM Board for DSP96000
DSPPCHOST *	PC compatible host board and interface software
DSPMACHOST	Macintosh II host board and interface software
DSPSUN4HOST *	Sun-4 host board and interface software
DSPCOMMAND	16-, 24-, 32-bit Command Converter board and software
DSP56002EVM	Evaluation board and software for DSP56002
DSP56007EVM	Evaluation board and software for DSP56007
DSP56009EVM	Evaluation board and software for DSP56009

\*Supported by Graphical User Interface

## Graphical User Interface

### For DSP Application Development Systems and Simulators

A number of Motorola's DSP development systems and simulators come with graphical user interface software to ease working on applications based on our product families.

#### User Friendly

- GUI works native to three operation systems:
  - SunOS
  - Windows 3.1
  - HPUX
- Multiple overlapping windows for the display of debugging information, command input registers, memory, and programs
- Pull down menus for ease of use:
  - Dialog boxes for selecting options of complex commands
  - Tool bar will provide fast access to commonly performed actions
  - Keyboard accelerators will be defined for commonly executed commands
  - Help viewer will be provided for viewing pre-defined help on selected topics

#### Debugging Capabilities for C Language and Assembly

- Assembly language symbolic or C Language source code debugging capabilities

## DSP Development Software Design-In Software Packages

The Simulator/Macro-Assembler/Linker/Librarian software package is a development system support tool. The Simulator program imitates the operation of the DSP on a clock-cycle by clock-cycle basis and gives an accurate measurement of code execution time. All on-chip peripheral operations, memory and register updates, and exception processing activities may be functionally simulated.

The full-featured Macro Cross Assembler translates one or more source files containing instruction mnemonics, operands, and assembler directives into a Common Object File Format (COFF) file, which is directly loadable by the Simulator. It supports the full instruction set, memory spaces, and parallel transfer fields of the DSP.

The Linker relocates and links relocatable COFF object modules from the Assembler to create an absolute load file, which can be loaded directly into the Simulator. The Librarian utility will merge separate, relocatable object modules into a single file, allowing frequently used modules to be grouped for convenient linking and storing.

The Assembler and Linker now provide support for assembly language source-level debugging via the Simulator. Global symbols, symbols local to sections, and even underscore labels may be referenced with all scoping

constructs intact. In addition, the assembler generates information about included files and macros. The assembler and linker also support numbered counters ranging from 0 to 65535.

#### PART NUMBERS

Simulator/Assembler/ Linker/Library	Host Machine
DSP56100CLASA *	IBM PC
DSP56100CLASB	Macintosh II (consult factory)
DSP56100CLASF *	Sun-4
DSP56100CLASH *	Hewlett-Packard Series 700
DSP56000CLASA *	IBM PC
DSP56000CLASB	Macintosh II (consult factory)
DSP56000CLASF *	Sun-4
DSP56000CLASH *	Hewlett-Packard Series 700
DSP56300CLASA *	IBM PC
DSP56300CLASF *	Sun-4
DSP56300CLASH *	Hewlett-Packard Series 700
DSP96000CLASA *	IBM PC
DSP96000CLASB	Macintosh II (consult factory)
DSP96000CLASF *	Sun-4
DSP96000CLASH *	Hewlett-Packard Series 700

\*Supported by Graphical User Interface

## C Compiler Packages

A full ANSI C compliant compiler, based on GNU technology, provides higher efficiency and implements more than twenty major optimization techniques. It has improved in-line assembly capability and an ANSI C preprocessor. The package includes the C Compiler, a new COFF Assembler, Linker, complete ANSI C Libraries, and a new C source level debugger as well as expanded user's reference manual. The software package is available for various host computers listed.

#### PART NUMBERS

GNU C Compiler	Host Machine
DSP56100 Family	
DSP561CCCA	IBM PC
DSP561CCCF	Sun-4
DSP561CCCH	Hewlett-Packard Series 700
DSP56000 Family	
DSP56KCCA	IBM PC
DSP56KCCF	Sun-4
DSP56KCCH	Hewlett-Packard Series 700
DSP53000 Family	
DSP563CCA	IBM PC
DSP563CCF	Sun-4
DSP563CCH	Hewlett-Packard Series 700
DSP96000 Family	
DSP96KCCA	IBM PC
DSP96KCCF	Sun-4
DSP96KCCH	Hewlett-Packard Series 700

## C Compiler Upgrades

Registered users of the earlier versions of the Motorola DSP C compiler can upgrade to the latest GNU C compiler for \$120. To order, contact a Motorola sales representative or distributor. Have your registration number ready.

#### PART NUMBERS

GNU C Compiler	Host Machine
DSP56000 Family	
DSP56KCCAJ	IBM PC
DSP56KCCFJ	Sun-4



# The M68000 Family

## ... the Upward Compatible 8-/16-/32-Bit Microprocessor Family

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### In Brief ...

#### An MPU For All Functions

To designers of the most advanced microcomputer systems, the Motorola M68000 Family of microprocessors needs no introduction. Products based on its members have become the standard for systems utilizing the UNIX operating system and for CAD/CAM engineering workstations. They are invading the next generation designs of personal computers and color graphics systems, and they find widespread implementation in multi-user/multi-tasking applications and in small business systems. M68000 MPUs are found in the leading products in fault-tolerant systems requiring high performance and parallel processing, and they are the preferred components for artificial intelligence engines requiring large linear addressing capabilities. Control applications include graphics, numerical controllers, robotics, telecommunications switching and PBX voice/data transmission.

#### Upward Compatibility

The M68000 MPU Family consists of a line of processors based on a 32-bit flexible register set, a large linear address space, a simple yet powerful instruction set and flexible addressing modes. The internal architecture of the 8-, 16-, and 32-bit MPU versions, and the common instruction set, provide software compatibility and offer an easy upward migration path for products requiring increasing levels of processing power.

#### A Host of Peripherals

A large selection of full-function peripheral chips complements the processor family. Compatible LSI and VLSI chips for memory management, data communications, DMA control, network control, system interfacing, general I/O and graphics, all simplify system design and reduce design and manufacturing cost while improving system performance.

	<b>Page</b>
Microprocessors .....	2.2-2
Embedded Controllers .....	2.2-5
Integrated Processors .....	2.2-7
Coprocessors .....	2.2-10
DMA Controllers .....	2.2-10
Network Devices .....	2.2-10
Data Communication Devices .....	2.2-12
General Purpose I/O .....	2.2-12
Fiber Distributed Data Interface .....	2.2-13
Support Software .....	2.2-13

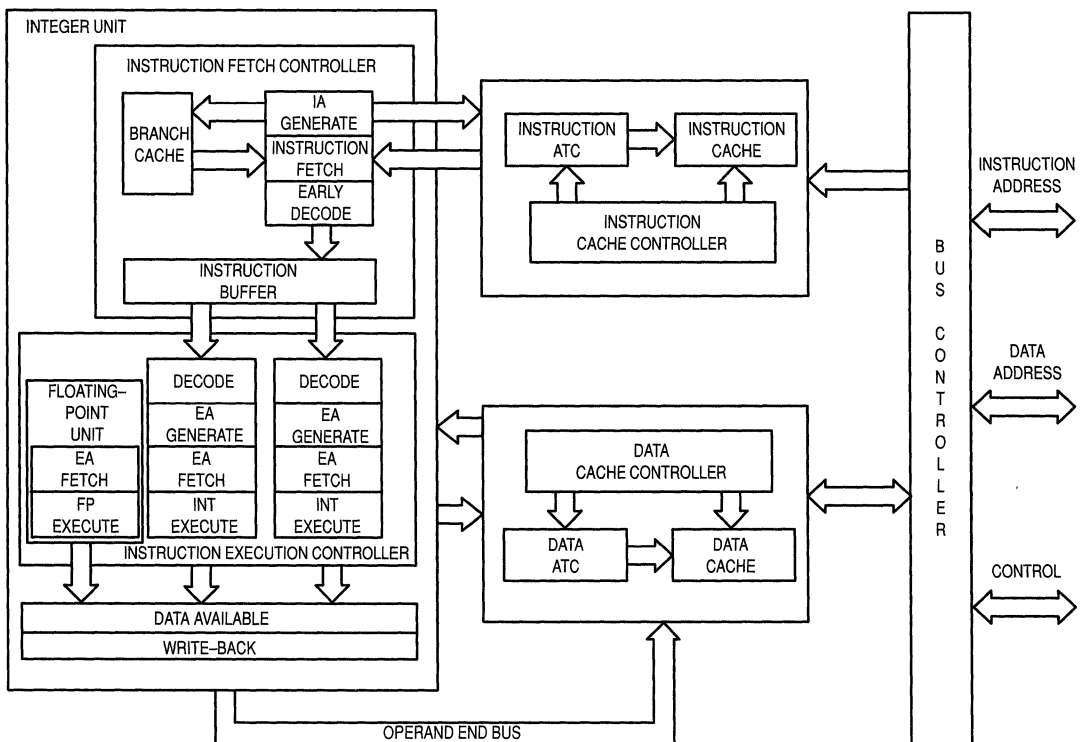
# Microprocessors

The 68K Family of Microprocessors has revolutionized virtually every segment of the electronic industry. They have set the standard for performance while still maintaining binary software compatibility from generation to generation. The combination of low cost and high performance (measured in \$/system MIPS) makes every member of the Family a price performance leader. The M68000 Family provides the widest range of price and performance with choices from 1.6 MIPS to over 100 MIPS.

**Table 1.**

	68000	68020	68030	68040	68060
MIPS	1.6	5.5	12	35	100
MFLOPS	–	0.25	0.5	3.5	12
Address Range	16M Byte	4G Byte	4G Byte	4G Byte	4G Byte
Data Bus	16 bit	32 bit	32 bit	32 bit	32 bit
Clock Speed (MHz)	8–16	16–33	16–50	25–40	50–66
Instruction Cache	–	256 Byte	256 Byte	4K Byte	8K
Data Cache	–	–	256 Byte	4K Byte	8K
Burst Mode	–	–	16 Byte R	16 Byte R/W	16 Byte R/W
General Purpose Registers	16	16	16	16	16
Address Modes	14	18	18	18	18
On-Chip MMU	No	No	Yes	Yes*	Yes*
Floating-Point Solution	68881	68882	68882	On-Chip	On-Chip

\*Separate Instruction/Data



**Figure 1. MC68060 Block Diagram**

## MC68060

### Superscalar 32-Bit Microprocessor

The MC68060 is fully compatible with all previous members of the M68000 family. The MC68060 features dual on-chip caches, fully independent demand-paged memory management units (MMUs) for both instructions and data, dual integer execution pipelines, on-chip floating-point unit (FPU) and a branch target cache. A high degree of instruction execution parallelism is achieved through the use of a full internal Harvard architecture, multiple internal buses, independent execution units, and dual instruction issue within the instruction controller. Power management is also a key part of the MC68060 architecture. The MC68060 offers a low-power mode of operation that is accessed through the LPSTOP instruction, allowing for full power-down capability. The MC68060 design is fully static so that when circuits are not in use, they do not draw power. Each unit can be disabled so that power is used only when the unit is enabled and executing an instruction.

Complete code compatibility with the M68000 family allows the designer to draw on existing code and past experience to bring products to market quickly. There is also a broad base of established development tools, including real-time kernels, operating systems, languages and applications, to assist in product design. The functionality provided by the MC68060 makes it the ideal choice for a range of high-performance computing applications as well as many portable applications that require low power and high performance.

## MC68040

### Third-Generation 32-Bit Microprocessor

The MC68040 is Motorola's third generation of M68000-compatible, high-performance, 32-bit microprocessors. The MC68040 is a virtual memory microprocessor employing multiple, concurrent execution units and a highly integrated architecture to provide very high performance in a monolithic HCMOS device. On a single chip, the MC68040 integrates an MC68030-compatible integer unit, an IEEE 754-compatible floating-point unit (FPU), and fully independent instruction and data demand-paged memory management units (MMUs), including independent 4K-byte instruction and data caches. A high degree of instruction execution parallelism is achieved through the use of multiple independent execution pipelines, multiple internal buses, and a full internal Harvard architecture, including separate physical caches for both instruction and data accesses. The MC68040 also directly supports cache coherency in multimaster applications with dedicated on-chip bus snooping logic.

The MC68040 is an enhanced, 32-bit, HCMOS microprocessor that combines the integer unit processing capabilities of the MC68030 microprocessor with independent 4K-byte data and instruction caches and an on-chip FPU. The MC68040 maintains the 32-bit registers available with the entire M68000 Family as well as the 32-bit address and data paths, rich instruction set, and versatile addressing modes. Instruction execution proceeds in parallel with accesses to the internal caches, MMU operations, and bus

controller activity. Additionally, the integer unit is optimized for high-level language environments. The MC68040 is user-object-code compatible with previous members of the M68000 Family and is specifically optimized to reduce the execution time of compiler-generated code. The MC68040 is implemented in Motorola's latest HCMOS technology, providing an ideal balance between speed, power, and physical device size.

Instruction execution is pipelined in both the integer unit and FPU. Independent data and instruction MMUs control the main caches and the address translation caches (ATCs). The ATCs speed up logical-to-physical address translations by storing recently used translations. The bus snoop circuit ensures cache coherency in multimaster and multiprocessing applications. The MC68040 FPU is user-object-code compatible with the MC68882 floating-point coprocessor. The FPU has been optimized to execute the most commonly used subset of the MC68882 instruction set, and includes additional instruction formats for single- and double-precision rounding of results.

The MMUs support multiprocessing, virtual memory systems by translating logical addresses to physical addresses using translation tables stored in memory. Each MMU has two transparent translation registers available that define a one-to-one mapping for address space segments ranging in size from 16 Mbytes to 4 Gbytes each. The instruction and data caches operate independently from the rest of the machine, storing information for fast access by the execution units. Each cache resides on its own internal address bus and internal data bus, allowing simultaneous access to both. The data cache provides writethrough or copyback write modes that can be configured on a page-by-page basis.

The MC68040 bus controller supports a high-speed, nonmultiplexed, synchronous external bus interface, which allows the following transfer sizes: byte, word (2 bytes), long word (4 bytes), and line (16 bytes). Line accesses are performed using burst transfers for both reads and writes to provide high data transfer rates.

## MC68030

### The Second Generation 32-Bit MPU

The 030 started with a high performance 020 core and added many performance improvement features including increased internal parallelism, dual on-chip caches with a burst fillable mode, dual internal data and address buses, improved bus interface, and on-chip paged memory management unit.

Two independent 32-bit address buses and two 32-bit data buses allow the CPU, caches, MMU, and the bus controller to operate in parallel, so the 030 can, for example, simultaneously access an instruction from the instruction cache, data from the data cache and instruction/data from external memory.

Performance is further enhanced by on-chip instruction and data caches. Separate 256-byte data and instruction caches reduce the access time and increase CPU throughput by providing data and instructions on-chip.

## MC68030 (continued)

Overall bus requirements are reduced and multiple processors can run more efficiently thanks to increased bandwidth of the 030 bus, achieved by the enhanced bus controller allowing high speed fills of both data and instruction caches.

The on-chip paged memory management unit translates logical address to the corresponding physical address in 1/2 the time required by the 020 and MC68851 Paged Memory Management Unit. Pipelining permits this translation to be performed in parallel with other functions so that no translation time is added to any bus cycle.

## MC68020 The Original 32-Bit Performance Standard

The MC68020, oh twenty, is the industry's leading 32-bit microprocessor because of high performance, architecture, ease of design-in, and long-range compatible growth path.

The 020 has a full 32-bit internal and 32-bit external, regular, symmetrical architecture designed with the customer in mind. It offers all the functionality of the other M68000 Family MPUs, and maintains software user-code compatibility which controls the expense of your product migration.

Programmers appreciate the large general purpose register set, simple yet powerful instruction set and the many flexible M68000 addressing modes. The unique on-chip instruction cache helps provide burst-mode operation to 12.5 MIPS.

The 020 is the proven leader in high performance systems in office automation, engineering workstations, fault tolerant computers, parallel processors, telephone switching systems, and intelligent controllers.

## MC68010 A Virtual Memory Enhancement

The MC68010 offers the advantage of Virtual Memory. A high-speed loop mode operation executes tight software loops faster to enhance performance. Its instruction continuation feature has made it the choice for fault-tolerant and parallel processing systems. The MC68010 can support a governing operating system which handles the supervisory chores of any number of subordinate operating systems.

## MC68HC000 A Micropower Alternative

HCMOS design gives the MC68HC000 all the functions and performance of its MC68000 predecessors . . . at one-tenth of the operating power requirements. With a maximum power dissipation of only 0.175 watts, the MC68HC000 is ideal for high-performance computer peripherals, industrial controllers, instrumentation and communications equipment.

## MC68HC001

### Low Power HCMOS 8-/16-/32-Bit Microprocessor

The MC68HC001 provides a functional extension of the MC68HC000 HCMOS 16-/32-bit microprocessor with the addition of statically selectable 8- or 16-bit data bus operation. The MC68HC001 is object-code compatible with the MC68HC000, and code written for the MC68HC001 can be migrated without modification to any member of the M68000 Family. This is possible because the user programming model is identical for all members of the M68000 Family and the instruction sets are proper subsets for the complete architecture.

## MC68000

### The 16-Bit Foundations

As the first member of the M68000 family, the state-of-the-art technology and advance circuit design concepts of the MC68000 16-bit MPU started a new trend in microprocessor architecture. Its seventeen 32-bit data and address registers permit rapid internal execution of its powerful yet simple instruction set. It is designed for large multiprocessing systems and realtime applications with vectored interrupts, seven priority levels and a 16 megabyte linear addressing space. It offers mainframe-like performance, supporting high-level languages and sophisticated operating systems.

The MC68000 MPU has been joined by more advanced products with even greater capabilities, yet it satisfies a large segment of the existing applications. It is extremely cost competitive and it remains one of the major growth products in the entire MPU line.

## MC68008

### An 8-Bit Compatible Competitor

With an 8-bit data bus and 32-bit internal architecture, the MC68008 offers performance that competes with a number of 16-bit MPUs. It has the same register set, same instructions, and the same functionality as the MC68000 with extensive exception processing. Large modular programs can be developed and executed efficiently because of the large, 1-megabit non-segmented, linear address space. It is the choice for high performance, cost effective, 8-bit designs, particularly those requiring a migration path to 16-bit or full 32-bit operation.

# Embedded Controllers

The principle elements of this popular microprocessor family have now been redesigned specifically for embedded applications. The new 68EC0x0 family including the 68EC000, EC020, EC030 and EC040 MPUs are all optimized for cost-sensitive embedded control designs. The 68EC0x0 family offers the high performance of the 680x0 family, yet streamlines the feature sets for embedded applications. The 68EC0x0 family completes the triad forming the M68000 family of compatible products: the 680x0 family of computer-class central processing units; the 68300 family of integrated processors; and now, the 68EC0x0 family of embedded microprocessors.

**Table 2.**

	68EC000	68EC020	68EC030	68EC040/ LC040	68040V	68EC060/ LC060
MIPS	2.5	6.5	10.7	44	44	100
Address Range	16M Byte	16M Byte	4G Byte	4G Byte	4G Byte	46
Data Bus	16 bit	32 bit	32 bit	32 bit	32 bit	32 bit
Clock Speeds	8, 10, 12, 16 MHz	16, 25 MHz	25, 40, 50 MHz	20, 25, 33, 40 MHz	25, 33, 40 MHz	50, 60 MHz
Instruction Cache	–	256 Byte	256 Byte	4K Byte	4K Byte	8K Byte
Data Cache	–	–	256 Byte	4K Byte	4K Byte	8K Byte
Burst Fill Caches	–	–	16 Bytes	16 Bytes	16 Bytes	16 Bytes
General Purpose Registers	16	16	16	16	16	16
Address Modes	14	18	18	18	18	18
Floating Point Hardware	68881/68882	68881/68882	68881/68882	None	None	None
Packages	PLCC	PPGA, PQFP	PPGA, CQFP	PGA, CQFP	PGA, CQFP	PGA, CQFP

## MC68EC/LC060 32-Bit High-Performance Embedded Controller

The 68EC060 is the newest addition to Motorola's embedded microprocessor family. It is the performance leader for top of the line embedded applications. The 68EC/LC060 offers 100 MIPS performance while maintaining complete backward compatibility with the 680x0 family. The 68LC060 offers a paged memory management unit while the 68EC060 has been optimized for embedded systems requiring lower-cost performance.

## MC68EC040 32-Bit High-Performance Embedded Controller

The EC040 is capable of delivering 44 MIPS of sustained performance with a system cost that is unattainable by competing architectures. The LC040 offers all the features of the EC040 plus adds a paged memory management unit allowing more sophisticated operating systems features, including better memory protection.

This impressive performance is a result of a six-level pipelined integer unit, independent four-way set-associative instruction and data caches, and a very high level of on-chip parallelism. The EC040 also supports multimaster and multiprocessor systems with bus snooping.

By integrating all these features into the EC040, the microprocessor is able to perform the vast majority of work on-chip, limiting external memory accesses to allow for higher system performance with less expensive DRAMs. The result is virtual immunity to the effects of memory wait states.

## MC68040V Low-Power 32-Bit Embedded Controller

The 68040V is a low-power version of the MC68LC040. Using advanced static design techniques and 3.3 Volt supply, this part offers all the performance and features of the LC040, but requires much less power. The 040V instruction set is fully 040 compatible, but adds a low-power STOP instruction to allow for software power-down of the processor to save power.

## Embedded Controllers (continued)

### MC68EC030

#### 32–Bit Enhanced Embedded Controller

The MC68EC030 is a 32–bit embedded controller that streamlines the functionality of an MC68030 for the requirements of embedded control applications. The MC68EC030 is optimized to maintain performance while using cost–effective memory subsystems. The rich instruction set and addressing mode capabilities of the MC68020, MC68030, and MC68040 have been maintained, allowing a clear migration path for M68000 systems. The MC68EC030 is object–code compatible with the MC68020, MC68030, and earlier M68000 microprocessors. Burst–mode bus interface is provided for efficient DRAM access.

The MC68EC030 has an on–chip data cache and on–chip instruction cache with 256 bytes each. Dynamic bus sizing is available for direct interfacing to 8–, 16–, and 32–Bit Devices. The MC68EC030 includes 32–bit nonmultiplexed address and data buses, sixteen 32–bit general–purpose data and address registers, and two 32–bit supervisor stack pointers and eight special–purpose control registers. The EC030 provides complete support for coprocessors with the M68000 coprocessor interface. There are two access control registers that allow blocks to be defined for cacheability protection. The pipelined architecture, along with increased parallelism, allows internal caches accesses in parallel with bus transfers and overlapped instruction execution. The enhanced bus controller supports asynchronous bus cycles (three clocks minimum), synchronous bus cycles (two clocks minimum), and burst data transfers (one clock).

### MC68EC020

#### 32–Bit Embedded Controller

The 68EC020, with a complete 32–bit internal implementation, has a 32–bit data bus and an on–chip instruction cache to provide dramatically increased performance over 8– and 16–bit microprocessors. In addition, upward migration to the EC020 is made simple with dynamic bus sizing, allowing 8, 16 and 32–bit peripherals to communicate with the microprocessor.

Other performance features include advanced bit manipulation capabilities that provide multiple bit shift operations in a single instruction cycle. This capability greatly simplifies and accelerates the bit operations required in graphics processing and optical recognition applications.

### MC68EC000

#### Low–Powered HCMOS Embedded Controller

The 68EC000 is a low–power HCMOS derivative of the 68000 optimized for cost–effective embedded processing. The EC000 has a flexible data bus that can operate in either 8– or 16–bit modes and a 24–bit address bus that provides 16 Mbytes of memory addressing capability. Electrical characteristics of the 68EC000 have been optimized to ensure easy access to low–cost memories.

The 68EC000 represents the lowest cost entry point to any 32–bit architecture. Coupled with efficient support for high–level languages and real–time operating systems, the 68EC000 provides unparalleled compatible migration paths to higher performance.

# Integrated Processors

Powerful solutions to cost-, space-, and power-sensitive embedded applications are provided by the 68300 family of integrated microprocessors and microcontrollers. The 68300 family combines two of Motorola's greatest strengths — the 32-bit microprocessor architecture of the 68000 family and a proliferation of peripheral circuits offering a growing family of integrated solutions.

The 68000 family is based on a proven, expandable architecture that spans the performance range from 1 to over 29 MIPS. This architecture offers the industry's highest level of compatibility for both hardware and software. Motorola's single-chip microcomputers and microcontrollers provide the industry's broadest selection of peripheral combinations, insurance that one will fit the need of practically any application. The 68300 family embraces both of these concepts.

Each member of the 68300 family contains a core processor based on the 68000 family, a System Integration Module (SIM), an on-chip bus and various peripheral modules. The SIMs include support circuitry such as clock generation, external chip selects, system protection, timers and JTAG. The on-chip intermodule bus (IMB) on the CPU32-based 68300s creates a standard interface over which the CPU and each of the modules communicate. The peripheral modules include specialized processors, system controllers, traditional peripherals and memory. Because the peripheral modules are independent from each other, they can appear in multiple 68300 devices. With so many major features incorporated into a single 68300 device, a system designer can realize improved reliability along with significant savings in design time, power consumption, cost, board space, pin count and program development. In a 68300 device, the major functions and glue logic are all properly connected, internally timed with the same fast clock, fully tested and consistently documented.

**Table 3.**

	68302	68306	68330	68331	68332	68333	68334	68340	68307	68322	68328
Core Processor	68000	68EC00	CPU32	CPU32	CPU32	CPU32	CPU32	CPU32	EC000	EC000	EC000
Speeds (MHz)	16, 20	16, 20	16, 25	16	16	16	16	16, 25	16	16, 20	—
DMA	Yes	—	—	—	—	—	—	Yes	—	Yes	—
Serial Processor	Yes	—	—	—	—	—	—	—	—	—	—
Time Processor Unit	—	—	—	—	Yes	Yes	Yes	—	—	—	—
Flash EEPROM	—	—	—	—	—	64K	—	—	—	—	—
Serial I/O	Yes	Yes	—	Yes	Yes	Yes	—	Yes	Yes	—	Yes
Timers	1	—	—	1	—	—	—	2	2	1	2
A/D Converter	—	—	—	—	—	Yes	Yes	—	—	—	—
SRAM	1K	—	—	—	2K	4K	1K	—	—	—	—
DRAM Controller	—	Yes	—	—	—	—	—	—	—	Yes	—
Glue Logic (SIM)	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes
3.3 Volts Available	—	—	—	—	—	—	—	Yes	Yes	—	Yes
Graphic Processor	—	—	—	—	—	—	—	—	No	Yes	No

## Integrated Processors (continued)

### MC68302

#### Integrated Multiprotocol Processor

The MC68302 integrated multiprotocol processor (IMP) is a very large-scale integration (VLSI) device incorporating the main building blocks needed for the design of a wide variety of controllers used in the communications industry. The IMP is the first device to offer the benefits of a closely coupled, industry-standard M68000/MC68008 microprocessor core and a flexible communications architecture. The three-channel communications device may be configured to support a number of popular industry interfaces, including those for the Integrated Services Digital Network (ISDN) basic rate and terminal adaptor applications. Through a combination of architectural and programmable features concurrent operation of different protocols (HDLC/SDLC™, UART, BISYNC, DDCMP™, or transparent modes) can easily be achieved. Data concentrators, modems, line cards, bridges, and gateways are examples of suitable applications for this device.

The IMP is a Complementary Metal-Oxide Semiconductor (CMOS) device consisting of an M68000/MC68008 microprocessor core, a system integration block (SIB), and a Communications Processor (CP). By integrating the microprocessor core with the serial ports (in the CP) and the system peripherals (in the SIB), the IMP is capable of handling complex tasks such as all ISDN basic rate (2B+D) access tasks.

### MC68306

#### Integrated 68EC000 Processor

The 68306 integrated EC000 processor includes many of the features commonly found in 68000-based designs. The 68306 includes a 68EC000 core processor, a 68681 Dual Universal Asynchronous Receiver Transmitter (DUART), system integration functions, and a DRAM controller. The on-chip DRAM controller gives the 68306 the family's simplest interface to DRAM-based designs. The DRAM controller easily accommodates 64 Mbytes of memory. The 68306 saves time in the design cycle by providing valuable 68000 system components pre-packaged in one chip.

### MC68307

#### Integrated EC000 Processor

The 68307 is an integrated processor combining a static EC000 processor with multiple inter-chip bus interfaces. The 68307 is designed to provide optimal integration and performance for applications such as digital cordless telephones, portable measuring equipment, and POS terminals. By providing 3.3 V, static operation in a small

package, the 68307 delivers cost effective performance to handheld battery-powered applications.

### MC68322

#### Integrated EC000 Printer Processor

The 68322 is a high-performance integrated printer processor that combines a 68EC000 core, a RISC graphics processor, a print engine video controller and numerous system integration features on a single integrated circuit. It is the first of Motorola's M68000 family designed specifically for printers. The 68322 provides a unique solution for new designs as well as an excellent migration path for existing M68000-powered printers.

### MC68328

#### Integrated EC000 Processor

The 68328 processor provides key features that are suitable for many portable applications. Modules like a real-time clock, LCD controller, pulse-width modulator, timers, master and slave serial peripheral interface, UART and system integration give the engineer more flexibility and resource to design efficient and innovative products.

### MC68330

#### Integrated CPU32 Processor

The 68330 is ideal for applications requiring 32-bit microprocessor performance without the additional expense inherent in 32-bit memory systems. The 68330 is the simplest and lowest priced member of the CPU32-based 68300 family. The 68330 allows the designer access to the high performance of the CPU32 along with minimized external glue logic, while allowing the greatest freedom in selecting needed peripherals, ASICs or gate arrays.

### MC68331

#### 32-Bit Microcontroller

The 68331 is well suited to applications requiring simple serial communications and general timing needs. The 68331 contains the CPU32, a SIM, a General Purpose Timer (GPT) and a Queued Serial Module (QSM). The general purpose timer is a simple yet flexible timer that provides four modes of operation with multiple channels for some operations. The QSM provides two modes of communication: an asynchronous channel that provides up to 524-Kbits per second transfer rate and a serial peripheral interface with separate 16-word receive/transmit queues.



## **MC68332**

### **32–Bit Microcontroller**

The 68332 is especially suited for high–performance timing applications such as automotive engine control, precision motor control and industrial robotics. The powerful Time Processor Unit (TPU) distinguishes the 68332 providing optimum performance in controlling time–related activity. It drastically reduces the need for CPU intervention with its dedicated execution unit, tri–level prioritized scheduler, data storage RAM and dual time bases. In addition to the TPU and CPU32, the 68332 features the QSM, a SIM and 2–Kbytes of standby static RAM.

## **MC68F333**

### **32–Bit Microcontroller**

The 68F333 provides the highest level of integration available to high–performance timing applications such as avionics and automotive engine control. The 68F333 contains the CPU32, the TPU and the QSM. It also adds two banks of flash EEPROM totaling 64–Kbytes, a total of 4–Kbytes of SRAM (512 bytes separately powered) and an 8–channel, 10–bit analog–to–digital converter. The Single–Chip Integration Module (SCIM) allows 18 of the external address and data pins to be converted to I/O pins, resulting in a single–chip solution suitable for many applications.

## **MC68334**

### **32–Bit Microcontroller**

The 68334 is a streamlined version of the 68332, taking advantage of the powerful TPU. The 68334 includes the CPU32 core processor, the TPU, a SIM, 1–Kbyte of SRAM, a 10–bit analog–to–digital converter and up to 47 discrete I/O lines.

## **MC68340**

### **Integrated Multiprotocol Processor with DMA**

The 68340 is excellent for applications requiring high–speed or block data transfers, such as disk drives and navigation systems. The combination of general peripherals and the extremely low power consumption possibilities of the 68340 make it ideal for many battery powered, portable applications such as hand held computers and data acquisition systems.

The most distinguishing 68340 feature is the high speed two channel, 32–bit Direct Memory Access (DMA) controller. Incorporating the CPU32 and DMA on the same chip eliminates the usual bus arbitration and synchronization delays, maximizing data throughput (25–Mbytes per second on a 16–bit bus).

In addition to the CPU32, a SIM and the DMA, the 68340 contains a 68681/2681–compatible DUART. The 68340 also has two identical, versatile counter/timers, each with a 16–bit counter and an 8–bit prescaler with 80 ns resolution.

# Coprocessors

## MC68851

### Paged Memory Management Unit, PMMU

The PMMU is a 32-bit memory manager which provides full support for a demand paged virtual environment with the 68010 or MC68020. It supports a 4-gigabyte addressing space when used as a coprocessor with the MC68020. An on-chip address translation cache minimizes translation delays and maximizes system performance.

## MC68881

### A Floating Point Coprocessor

Designed specifically for arithmetic expansion of the MC68020 MPU, this powerful coprocessor can also be used as a peripheral to all other M68000 family members, and with non-M68000 processors as well. It performs floating point math calculations in strict conformance to a full implementation of the IEEE Standard for Binary Floating Point Arithmetic (754) and, in addition to the basic add, subtract, multiply, and divide functions, it handles full selection of transcendental and non-transcendental operations. These operations include root values, trigonometric functions, exponentials, hyperbolics, and logs. All functions are calculated to 80 bits of extended precision in hardware.

## MC68882

### Enhanced Floating Point Coprocessor

The MC68882 is pin-to-pin hardware and software compatible with the MC68881 Floating Point Coprocessor and implements a variety of performance enhancements including dual-ported registers and an advanced pipeline. Additional circuitry allows execution of multiple instructions in parallel for more than twice the Floating Point performance of the trail-blazing MC68881. Where higher performance requirements indicate, the MC68882 is a drop-in replacement for the MC68881.

# DMA Controllers

## MC68450

### DMA Controller, DMAC

The DMAC maintains high-performance data movement for complex M68000 MPU-based systems. While pin compatible with the MC68440 DDMA, the DMAC offers four completely independent DMA channels. In addition to all the

features of the DDMA, the DMAC also provides very sophisticated manipulation of data through sequential and linked array-chained addressing capabilities.

## MC68440

### Dual Direct Memory Access Controller, DDMA

The DDMA complements the performance capabilities of M68000 microprocessors by moving blocks of data in a quick, efficient manner with a minimum of intervention from the MPU. The DDMA performs memory-to-memory, peripheral-to-memory, and memory-to-peripheral transfers through each of two completely independent DMA channels. The DDMA also offers two interrupt vectors per channel and supports both 8-bit and 16-bit data transfers.

# Network Devices

## MC68824

### Token Bus Controller, TBC

The TBC is the industry's first single-chip VLSI device to implement the IEEE 802.4 Media Access Control Sublayer of the ISO Data Link Layer, as specified by General Motors Manufacturing Automation Protocol, MAP. The TBC supports serial data rates of 1, 5, and 10 Mbps and relieves the host processor of the frame formatting and token management functions. For efficient transfer of data frames, to and from memory, the TBC features an on-chip four-channel DMA with bus master capability, a 32-bit address range, an 8- or 16-bit data bus, and a 40-byte FIFO. The MC68824 also offers support options for network bridges, real-time support and network monitoring services.

## MC68184

### Broadband Interface Controller

The MC68184 Broadband Interface Controller (BIC) is a high-performance interface device for use with the MC68824 Token Bus Controller (TBC) to implement the digital portion of the physical layer of a broadband IEEE 802.4 token bus node. The BIC manipulates both data and control for RF transmitter circuitry and RF receiver circuitry. The CMOS BIC supports data rates up to 10 Mbps using a duo-binary modulation technique and provides 20 lines for receiver/transmitter control with 13 user-defined outputs.

The BIC performs the digital functions of the physical layer when implementing a broadband token bus node. The modem side of the BIC provides data and control for the RF transmitter/receiver circuitry. A standard serial interface is used to connect the BIC to the MC68824 TBC. The TBC performs the media access control (MAC) function. The MC68184 has the ability to scramble and descramble data.

## Network Devices: (continued)

### MC68185

#### Twisted-Pair Modem

The MC68185 Twisted-Pair Modem (TPM) is used in conjunction with a MC68824 Token Bus Controller (TBC), an RS485 transceiver, and a twisted-pair media to implement a low-cost area network (LAN). The MC68824 TBC implements the layer 2 media access control (MAC) portion of the IEEE 802.4 LAN station and receiver portion for the IEEE 802.2 logical link control (LLC) type 3 as well as providing support for LLC type 1 and type 2. The TPM interfaces directly to the TBC, providing physical layer management, including MAC symbol encoding/decoding at data rates up to 2 Mbps.

The TPM contains an 32 kHz to 20 MHz on-chip crystal oscillator that generates a transmit clock without external circuitry. The physical layer management includes local loopback mode, transmitter enable, and reset. An on-chip digital filter provides for noise reduction of received data.

### MC68194

#### Carrierband Modem

The bipolar LSI MC68194 Carrierband Modem (CBM), when combined with the MC68824 Token Bus Controller (TBC), provides an IEEE 802.4 single-channel, phase-coherent carrierband, Local Area Network (LAN) connection. The CBM performs the physical layer function, including symbol encoding/decoding, signal transmission and reception, and physical management.

The CBM provides the three basic functions of the physical layer: data transmission to the coaxial cable, data reception from the cable, and management of the physical layer. For standard data mode (also called MAC mode), the CBM receives a serial transmit data stream from the TBC (called symbols or atomic symbols), encodes, modulates the carrier, and transmits the signal to the coaxial cable. Also in the data mode, the CBM receives a signal from the cable, demodulates the signal, recovers the data, and sends the received data symbols to the TBC. End-of-transmission receiver blanking as required by IEEE 802.4 is supported. Communication between the TBC and CBM is through a standardized serial interface consistent with the IEEE 802.4 DTE-DCE interface.

### MC68195

#### Local Talk Adaptor

The MC68195 LocalTalk adaptor (LA) is used in conjunction with the MC68302 Integrated Multiprotocol Processor (IMP) to build a network interface to LocalTalk™, also known as AppleTalk™. LocalTalk refers to the 230.4-kbps Local Area Network (LAN) that connects multiple Macintosh™ computers and printers.

The LA provides LocalTalk support for any two of the three IMP serial channels. Combinations of multiple LA and/or IMP devices may be used to support additional LocalTalk channels. Non-LocalTalk applications can use the LA device with the IMP to build proprietary HDLC-based LANs at up to 2.5 Mbps using bi-phase space (FMO) encoding.

### MC68605

#### X.25 Protocol Controller, XPC

The XPC implements the 1984 CCITT X.25 Recommendation Data Link Procedure (level 2) LAPB. In addition to handling the lower level communications functions (HDLC framing, CRC generation/checking, and zero insertion/deletion), the XPC also independently handles higher level communications functions (frame sequencing, retransmission, flow control, retries limit and timeout conditions). This allows the host to operate almost totally isolated from the task of ensuring error-free transmission and reception of data.

### MC68606

#### Multi-Link LAPD Controller CCITT Q.920/Q.921, LAPD

The MC68606 Multi-link LAPD (MLAPD) Protocol Controller fully implements CCITT Recommendation Q.920/Q.921 Link Layer Access Procedure (LAPD) protocol for ISDN networks. The MLAPD is designed to handle both signalling and data links in high-performance ISDN primary rate applications.

This VLSI device provides a cost-effective solution to ISDN link-level processing with simultaneous support for up to 8K logical links. The MC68606 is an intelligent communications protocol controller compatible with AT&T specifications for ISDN devices and features low power consumption and high performance, with an aggregate data rate in excess of 2.048 Mbps.

## Data Communication Devices

### MC68HC681

### MC68HC2681

#### Dual Universal Asynchronous Receiver/Transmitter, DUART

The MC68HC681 features two completely independent full-duplex asynchronous receiver/transmitter channels that interface directly to the M68000 microprocessor bus. Receiver data registers are quadruple buffered and transmitter data registers are double buffered for minimum MPU intervention. Each has its own independently selectable baud rate. Multifunction 6-bit input port and 8-bit output port, a 16-bit programmable counter/timer, interrupt handling capabilities, and a maximum one-megabyte per second transfer rate make the DUART an extremely powerful device for complex data communication applications. Full device functionality with an M6800 bus interface is provided by the MC68HC2681.

## General Purpose I/O

### MC68230

#### Parallel Interface/Timer, PI/T

The PI/T provides versatile double-buffered parallel interfaces and a system-oriented timer for M68000 systems. The parallel interfaces operate either in a unidirectional or bidirectional mode, either 8- or 16-bit wide. The timer is 24 bits with full programmability and a 5-bit prescaler. The PI/T has a complete M68000 bus interface and is fully compatible with the MC68450 DMAC.

### MC68HC901

#### Multifunction Peripheral, MFP

The MFP provides basic microcomputer function requirements as a single companion chip to the M68000 Family of Microprocessors. Features provided via a direct M68000 system bus interface include a full-function, single-channel Universal Serial Asynchronous Receiver/Transmitter (USART) for data communication, an 8-source interrupt controller, eight parallel I/O lines, and four 8-bit timers.

# Fiber Distributed Data Interface

Fiber Distributed Data Interface (FDDI) is defined as a dual fiber-optic token ring LAN (Local Area Network) that can support rates up to 100 Mbps. It can accommodate rings with 1,000 stations. Two kilometers between stations, and up to 200 kilometers in total length. This technology is driven by the need to support high performance distributed computer systems which are becoming faster and more powerful, thus imposing a greater need for network speed and bandwidth. Other uses for FDDI include backbone networks connecting Ethernet, Token Bus, and Token Ring segments and back end networks connecting high-speed peripherals. FDDI is an American National Standards Institute (ANSI) standard. Motorola's FDDI chip set includes the MC68836, MC68837, MC68838, and MC68839.

## MC68836

### FDDI Clock Generator

The MC68836 FDDI Clock Generator (FCG) implements part of the Physical Layer (PHY) functions of the FDDI standard including clock recovery, data recovery, and NRZI conversions. The FCG also does a five-bit parallel to serial conversion during transmission, and a serial to five-bit parallel conversion during reception. The FCG uses the five-bit parallel interface to communicate with the MC68837 device. The FCG directly connects to fiber optic modules through differential driver/receiver pins. Features include full duplex operations, 125 MHz clock recovery from incoming serial NRZI data stream, and 125 MHz transmit clock generation.

## MC68837

### Elasticity Buffer and Link Manager

The Elasticity Buffer and Link Manager (ELM) implements the remaining of the PHY functions of the FDDI standard including data framing, elasticity buffer, encoding, decoding, smoothing, line state detection, and repeat filter. The ELM also implements some Station Management (SMT) functions such as the Connection Management (CMT), Physical Connection Management (PCM), Physical Connection Insertion (PCI), and Link Error Monitor (LEM).

## MC68838

### Media Access Controller

The Media Access Controller (MAC) implements the MAC portion of the FDDI standard. The MAC protocol is the lower sub-layer of the ISO OSI data link layer and provides for fair and deterministic sharing of the physical medium, address recognition, frame check sequence generation and verification, frame insertion, frame repetition, frame removal, token generation, and certain error recovery procedures. Features on the MC68838 include independent receive and transmit data paths and state machines, bridging support including a bit order reversal option, a count and void frame bridge stripping algorithm, and CRC appendage on a per frame basis. The MAC also contains an interface to Content Addressable Memory (CAM) for individual and multicast address recognition.

## MC68839

### FDDI System Interface

The FDDI System Interface (FSI) is a high performance interface device which can easily connect to any bus including high speed processors, little- and big-endian busses, and multiplexed/non-multiplexed address data busses. Its primary purpose is to interface the FDDI protocol devices to the user system bus. FSI features include support for a ring buffer structure, addressing flexibility, programmable partitioned 8K bytes internal RAM for temporary data storage, two 32-bit ports, the ability to sustain up to 250  $\mu$ s bus latencies, support for synchronous and asynchronous frames, and the ability to chain multiple buffers per frame.

## Support Software

### M68KESW-PC1

This Intermetrics software package is for the 68K Family (68000, 68008, 68HC001, 68010, 68020, 68030, 68EC030, 68040, 683xx). The MC68KESW InterTools package includes C compiler, assembler/linker, run-time libraries, and one year of support from Intermetrics.

### M68040FPSP

This software provides 68040 floating point emulation of unimplemented 68881/68882 functions. Contact factory for license agreement.



# The M88000 RISC Family

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## In Brief . . .

Motorola's 88000 Family comes from the only company committed to long-term upward software compatibility through such features as hardware interlocked and protected pipelines. Our goal is to make sure each generation of the 88000 RISC family delivers a high performance level while maintaining software compatibility.

	<b>Page</b>
Architecture, Performance, and Software Compatibility . . . . .	2.3-2
Microprocessors . . . . .	2.3-2
Cache/Memory Management Units . . . . .	2.3-3

# Motorola's 88000 RISC Microprocessors

... a performance architecture

## Architecture, Performance, and Software Compatibility

The 88000 RISC was designed from the start for superscaler implementations. In fact, the design of the second generation 88110 microprocessor is a unique superscaler implementation called Symmetric Superscalar™. The Symmetric Superscaler design allows you to execute multiple instructions in a single clock cycle without any restrictions on instruction ordering. So there are no wait states or performance penalties because of out of order instructions.

Also, while other RISC microprocessors may be limited in the instructions they can execute in a single clock cycle, members of the 88000 are able to execute multiple instructions per clock cycle, thus providing the performance edge required for next generation system designs.

## Performance Plus Software Compatibility

Although high performance is recognized as a key feature for systems design, software compatibility is also important. Motorola's 88000 Family comes from the only company committed to long term upward software compatibility through such features as hardware interlocked and protected pipelines. Our goal is to make sure each generation of the 88000 RISC family delivers a high performance level while maintaining software compatibility. This gives the opportunity for designing one of the industry's highest performance systems, while leveraging your largest dollar investment in new systems, your software.

Software compatibility is also promoted through standards to provide an open systems environment benefitting system companies, software developers, and end users because 88000 based systems from different vendors will run all of the same software.

## Microprocessors

### MC88100RC

#### 32-Bit RISC Microprocessor

The MC88100 is the first processor in the 88000 Family of RISC (reduced instruction set computer) microprocessors. Implemented with Motorola's HCMOS technology, the MC88100 incorporates 32-bit registers, data paths, and addresses. In designing the MC88100, Motorola has incorporated a high degree of fine-grain parallelism; four independent execution units maintain separate, fully concurrent execution pipelines. Most instructions operate in one machine cycle or effective concurrent execution can be accomplished through internal pipelines in one machine cycle.

A common register file provides data sharing and synchronization control among the execution units through register scoreboarding.

The MC88100 addresses a variety of applications requiring high operational speeds and efficient, fast-execution architectures. All data manipulation instructions are nondestructive register to register or register with immediate operations, allowing both fast operand access and operand reuse. IEEE 754 floating-point arithmetic is supported in the processor. Instruction and data memory space are accessed through separate memory ports, allowing simultaneous access to dedicated memory areas. The 88000 Family includes the MC88200 CMMU (cache/memory management unit), which adds high-speed memory caching, two-level, demand-paged memory management, and support for shared-memory multiprocessing. The 88000 Family also includes a full line of highly optimizing compilers, operating systems, development boards, and development tools.

### MC88110RC

#### 32-Bit RISC Microprocessor

The MC88110 is the second implementation of the 88000 family of reduced instruction set computer (RISC) microprocessors. The MC88110 is a Symmetric Superscaler machine capable of issuing and retiring two instructions per clock without any special alignment, ordering, or type restrictions on the instruction stream. Instructions are issued to multiple execution units, execute in parallel, and can complete out of order, with the machine automatically keeping results in the correct program sequence. The Symmetric Superscaler design allows sustained performance to approach the peak performance capability.

The MC88110 uses dual instruction issue and simple instructions with extremely rapid execution times to yield maximum efficiency and throughput for 88000 systems. Instructions either execute in one clock cycle, or effective one clock cycle execution is achieved through internal pipelining. Ten independent execution units communicate with a general register file and an extended register file through multiple 80-bit internal buses. Each of the register files has sufficient bandwidth to supply four operands and receive two results per clock cycle. Each of the pipelined execution units, including those that execute floating-point and data movement instructions, can accept a new instruction and retire a previous instruction on every clock cycle.

In a single chip implementation, the MC88110 integrates the central processing unit, floating point unit, graphics processing unit, virtual memory address translation, instruction cache, and data cache. The MC88110 maintains compatibility with MC88100 user application software.



# Cache/Memory Management Units

## MC88200RC

### 16-Kilobyte Cache/Memory Management Unit (CMMU)

The MC88200 CMMU is a high-performance, HCMOS VLSI device providing zero-wait-state memory management and data caching. The MMU (memory management unit) efficiently supports a demand-paged virtual memory environment with two logical address ranges (user/supervisor) of 4 gigabytes each. Translated addresses are provided by one of two ATCs (address translation caches), providing address translation in one clock cycle for most memory accesses. The PATC (page address translation cache) is a 56-entry, fully associative cache containing recently used translations for 4-kilobyte memory pages and is maintained by MC88200 hardware. The BATC (block address translation cache) is a 10-entry cache, loaded by software, containing translations for 512-kilobyte memory blocks. The BATC translations are used for operating system software or for other memory-resident instructions and data. In addition, the MMU provides access control for the two logical address spaces. The CMMU data cache is a 16-kilobyte, four-way, set-associative cache for instruction or data storage. The cache incorporates memory-update policies and cache-coherency mechanisms that support multiprocessor applications. The MC88200 CMMU also includes an MC88100-compatible P bus (processor bus) interface and an M bus (memory bus) interface. A processor may use two or more CMMUs for increased data cache and ATC sizes.

## MC88204RC

### 64K-Byte Cache/Memory Management Unit (CMMU)

The MC88204 CMMU is a high-performance, HCMOS VLSI device providing zero-wait-state memory management and data caching. The memory management unit (MMU) efficiently supports a demand-paged virtual memory environment with two logical address ranges (user/supervisor) of 4 Gbytes each. Translated addresses are provided by one of two address translation caches (ATCs), providing address translation in one clock cycle for most memory accesses. The page address translation cache (PATC) is a 56-entry, fully associative cache containing recently used translations for 4K-byte memory pages and is

maintained by MC88204 hardware. The block address translation cache (BATC) is a 10-entry cache, loaded by software, containing translations for 512K-byte memory blocks. The BATC translations are used for operating system software or for other memory-resident instructions and data. In addition, the MMU provides access control for the two logical address spaces. The CMMU data cache is a 64K-byte, four-way set-associative cache for instruction or data storage. The cache incorporates memory-update policies and cache-coherency mechanisms that support multiprocessor applications. The MC88204 CMMU also includes an MC88100-compatible processor bus (P bus) interface and memory bus (M bus) interface.

The MC88204 CMMU is completely software and pin-level compatible with the MC88200 16K-byte CMMU. The functionality of the MC88204 is identical to that of the MC88200. With board layout constraints in mind, a central processing unit (CPU) may use up to two MC88204 CMMUs on the data P bus and up to two MC88204 CMMUs on the instruction P bus to increase data cache and ATC sizes.

## MC88410

### Secondary Cache Controller

The MC88410 is a highly integrated secondary cache controller for the MC88110 microprocessor that reduces memory latency and extends multiprocessing capability for those seeking the highest level of system performance. Used with the MCM62110 Fast Static RAM, it provides a functionally complete secondary cache solution for both uniprocessor and multiprocessor environments. The MC88410 provides tag, control and buffering for 1/4, 1/2, and 1 Mbyte secondary cache configurations, all in a single chip cache controller. The MC88410 eliminates external logic between the processor and the secondary cache, provides bus arbitration for the MC88110, and requires no external programming.

The MC88410 and MCM62110 are optimized to provide low latency memory access to the MC88110 processor. Initial accesses incur only one wait state. Subsequent transactions in a burst incur zero wait states. Data streaming to the processor reduces the penalty on secondary cache misses.

The MC88410 expands the MC88110's system flexibility by providing a choice of secondary cache line size, burst byte ordering, and system clock frequency. The MC88410 extends the MC88110 multiprocessing capability by significantly reducing system bandwidth consumption. This increased available bandwidth, along with the MC88410's hardware enforced cache coherency protocol, enable the implementation of dual bus systems and scalable shared-bus multiprocessing systems.



# The PowerPC™ RISC Family Microprocessors

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## In Brief . . .

The PowerPC architecture is derived from the IBM Performance Optimized with Enhanced RISC (POWER) architecture. The PowerPC architecture shares all of the benefits of the POWER architecture but is optimized for single-chip implementations. The architecture design emphasizes parallel instruction execution and high throughput and allows for exceptional floating-point performance. The PowerPC architecture is powerful today and is scalable from palmtops to mainframes.

	<b>Page</b>
PowerPC™ RISC Microprocessors . . . . .	2.4-2
MPC601 RISC Microprocessor . . . . .	2.4-2
MPC602 RISC Microprocessor . . . . .	2.4-3
MPC603 RISC Microprocessor . . . . .	2.4-3
MPC603e RISC Microprocessor . . . . .	2.4-6
MPC604 RISC Microprocessor . . . . .	2.4-9
MPC604e RISC Microprocessor . . . . .	2.4-9
MPC620 RISC Microprocessor . . . . .	2.4-13
MPC105 PCI Bridge/Memory Controller . . . . .	2.4-15
MPC106 PCI Bridge/Memory Controller . . . . .	2.4-16

# PowerPC™ RISC Microprocessors

The PowerPC Architecture™, developed jointly by Motorola, IBM, and Apple, is based on the POWER Architecture™ implemented by the RISC System/6000™ family of computers. The PowerPC architecture takes advantage of recent technological advances in such areas as process technology, compiler design, and RISC (reduced instruction set computer) microprocessor design to provide software compatibility across a diverse family of implementations, primarily single-chip microprocessors, intended for a wide range of systems, including battery-powered personal computers, embedded controllers, high-end scientific and graphics workstations, and multiprocessing, microprocessor-based mainframes.

To provide a single architecture for such a broad assortment of processor environments, the PowerPC architecture is both flexible and scalable.

The flexibility of the PowerPC architecture offers many price/performance options. Designers can choose whether to implement architecturally-defined features in hardware or in software. For example, a processor designed for a high-end workstation has greater need for the performance gained from implementing floating-point normalization and denormalization in hardware than a battery-powered, general-purpose computer might.

The PowerPC architecture is scalable to take advantage of continuing technological advances — for example, the continued miniaturization of transistors makes it more feasible to implement more execution units and a richer set of optimizing features without being constrained by the architecture.

The PowerPC architecture defines the following features:

- Separate 32-entry register files for integer and floating-point instructions. The general-purpose registers (GPRs) hold source and target data for integer arithmetic instructions, and the floating-point registers (FPRs) hold source and target data for floating-point arithmetic instructions.
- Instructions for loading and storing data between the memory system and either the FPRs or GPRs.
- Uniform-length instructions to allow simplified instruction pipelining and parallel processing instruction dispatch mechanisms.
- Nondestructive use of registers for arithmetic instructions in which the second, third, and sometimes the fourth operand, typically specify source registers for calculations whose results are typically stored in the target register specified by the first operand.
- A precise exception model (with the option of treating floating-point exceptions imprecisely).
- Floating-point support that includes IEEE-754 floating-point operations.
- The ability to perform both single- and double-precision floating-point operations.

- A flexible architecture definition that allows certain features to be performed in either hardware or with assistance from implementation-specific software depending on the needs of the processor design.
- User-level instructions for explicitly storing, flushing, and invalidating data in the on-chip caches. The architecture also defines special instructions (cache block touch instructions) for speculatively loading data before it is needed, potentially reducing the effect of memory latency.
- Definition of a memory model that allows weakly-ordered memory accesses. This allows bus operations to be reordered dynamically, which improves overall performance and in particular reduces the effect of memory latency on instruction throughput.
- Support for separate instruction and data caches (Harvard architecture) and for unified caches.
- Support for both big- and little-endian addressing modes.
- Support for 64-bit addressing. The architecture supports both 32-bit or 64-bit implementations. This document typically describes the architecture in terms of the 64-bit implementations in those cases where the 32-bit subset can be easily deduced.

## MPC601 RISC Microprocessor

The MPC601 is the first implementation of the PowerPC architecture. The MPC601 implements the 32-bit portion of the PowerPC architecture, which provides 32-bit effective (logical) addresses, integer data types of 8, 16, and 32 bits, and floating-point data types of 32 and 64 bits. For 64-bit PowerPC implementations, the PowerPC architecture provides 64-bit integer data types, 64-bit addressing, and other features required to complete the 64-bit architecture.

The MPC601 is a superscalar processor capable of issuing and retiring three instructions per clock, one to each of three execution units. Instructions can complete out of order for increased performance; however, the MPC601 makes execution appear sequential.

The MPC601 integrates three execution units — an integer unit (IU), a branch processing unit (BPU), and a floating-point unit (FPU). The ability to execute three instructions in parallel and the use of simple instructions with rapid execution times yield high efficiency and throughput for MPC601-based systems. Most integer instructions execute in one clock cycle. The FPU is pipelined so a single-precision multiply-add instruction can be issued every clock cycle.

The MPC601 includes an on-chip, 32-Kbyte, eight-way set-associative, physically addressed, unified instruction and data cache and an on-chip memory management unit (MMU). The MMU contains a 256-entry, two-way set-associative, unified translation look-aside buffer (UTLB) and provides support for demand paged virtual memory address translation and variable-sized block translation. Both the UTLB and the cache use least recently used (LRU) replacement algorithms.

The MPC601 has a 64-bit data bus and a 32-bit address bus. The MPC601 interface protocol allows multiple masters to compete for system resources through a central external arbiter. Additionally, on-chip snooping logic maintains cache coherency in multiprocessor applications. The MPC601 supports single-beat and burst data transfers for memory accesses; it also supports both memory-mapped I/O and I/O controller interface addressing.

The MPC601 uses an advanced, 3.6-volts (601) or 2.5 volts (601v) CMOS process technology and maintains full interface compatibility with TTL devices.

#### Block Diagram

Figure 1 provides a block diagram of the MPC601 that illustrates how the execution units — IU, FPU, and BPU — operate independently and in parallel.

## MPC602 RISC Microprocessor

The MPC602 is a low-cost, low-power implementation of the PowerPC RISC architecture. The MPC602 implements the 32-bit portion of the PowerPC architecture, which provides 32-bit effective addresses, integer data types of 8, 16, and 32 bits, and floating-point data types of 32 and 64 bits. Floating-point operations involving either 32- or 64-bit data types in single-precision format are supported; however, floating-point operations involving 64-bit data types in double-precision format are not implemented in hardware and are instead trapped for emulation in software.

The MPC602 has four execution units—an integer unit (IU), a floating-point unit (FPU), a branch processing unit (BPU), and a load/store unit (LSU). The ability to execute four instructions in parallel and the use of simple instructions with rapid execution times yield high efficiency and throughput for MPC602-based systems. Most integer instructions execute in one clock cycle. The FPU is pipelined such that typically when the FPU pipeline is full, a single-precision instruction can complete every clock cycle.

The MPC602 provides dynamic and static power-saving modes. The three static modes — nap, doze, and sleep — progressively reduce the amount of power dissipated by the processor.

The MPC602 provides independent on-chip, 4-Kbyte, two-way set-associative, physically addressed caches for instructions and data and on-chip instruction and data memory management units (MMUs). The MPC602 MMUs contain 32-entry, two-way set-associative, data and instruction translation lookaside buffers (DTLB and ITLB). The MPC602 provides an additional memory protection mechanism not defined by the PowerPC architecture. The 602's protection-only mode can control whether instructions can be fetched from 4-Kbyte instruction pages and whether data can be written to 4-Kbyte data pages.

The MPC602 has a single bus interface used for transferring both 32-bit addresses and either 32- or 64-bit data. This bus is time-multiplexed. The MPC602 interface protocol allows multiple masters to compete for system resources through a central external arbiter. The MPC602 provides a three-state coherency protocol that supports the modified, exclusive, and invalid (MEI) cache states. This protocol is a compatible subset of the MESI (modified/exclusive/shared/invalid) four-state protocol and operates coherently in systems that contain four-state caches.

The MPC602 uses an advanced, 3.3-V CMOS process technology and maintains full interface compatibility with TTL devices.

#### Block Diagram

The MPC602 block diagram in Figure 2 illustrates how the execution units — IU, FPU, BPU, and LSU — operate independently and in parallel.

## MPC603 RISC Microprocessor

The MPC603 is the first low-power implementation of the PowerPC architecture. The MPC603 implements the 32-bit portion of the PowerPC architecture, which provides 32-bit effective (logical) addresses, integer data types of 8, 16, and 32 bits, and floating-point data types of 32 and 64 bits. For 64-bit PowerPC implementations, the PowerPC architecture provides 64-bit integer data types, 64-bit addressing, and other features required to complete the 64-bit architecture.

The MPC603 provides four software controllable power-saving modes. Three of the modes (the nap, doze, and sleep modes) are static in nature, and progressively reduce the amount of power dissipated by the processor. The fourth is a dynamic power management mode that causes the functional units in the MPC603 to automatically enter a low-power mode when the functional units are idle without affecting operational performance, software execution or any external hardware.

The MPC603 is a superscalar processor capable of issuing and retiring a maximum of three instructions per clock. Instructions can execute out of order for increased performance; however, the MPC603 makes completion appear sequential.

The MPC603 integrates five execution units — an integer unit (IU), a floating-point unit (FPU), a branch processing unit (BPU), a load/store unit (LSU) and a system register unit (SRU). The ability to execute five instructions in parallel and the use of simple instructions with rapid execution times yield high efficiency and throughput for MPC603-based systems. Most integer instructions execute in one clock cycle. The FPU is pipelined so a single-precision multiply-add instruction can be issued every clock cycle.

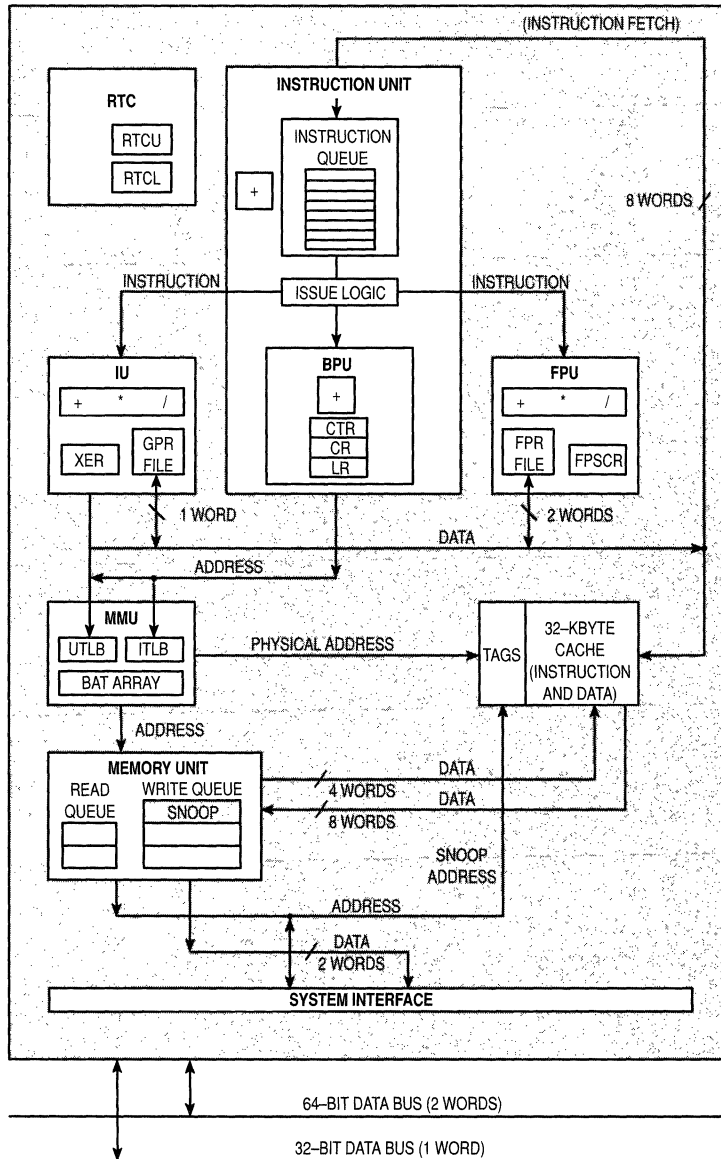


Figure 1. MPC601 Block Diagram

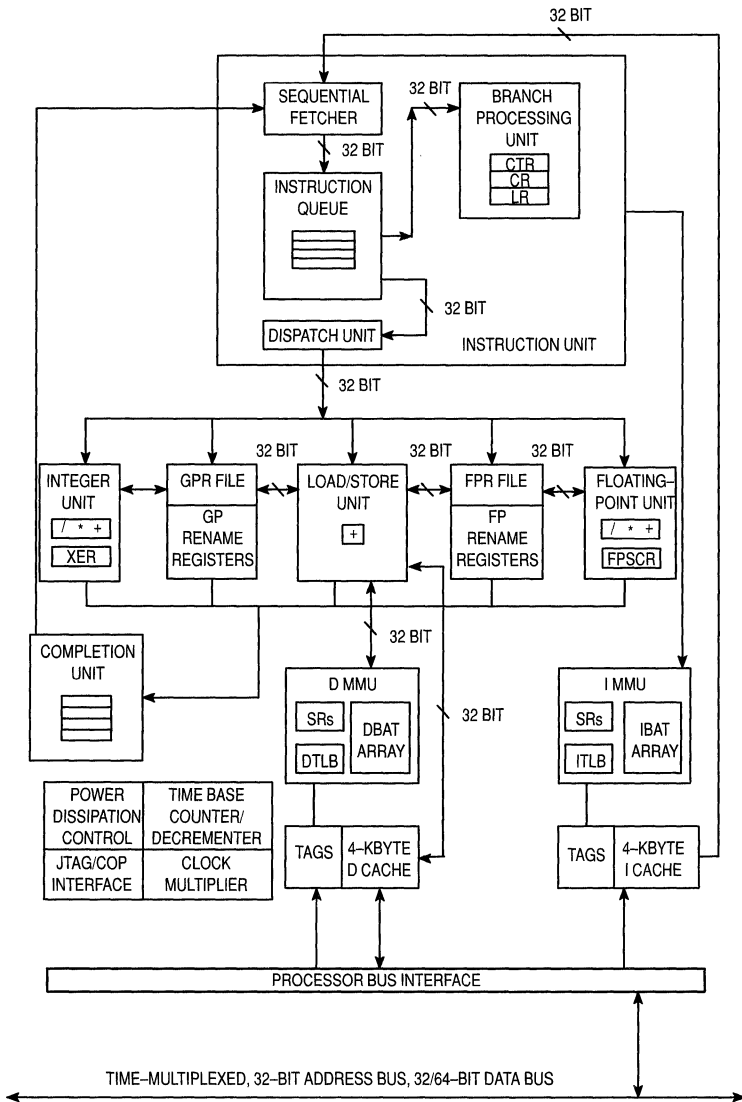


Figure 2. MPC602 Block Diagram

The MPC603 provides independent on-chip, 8-Kbyte, two-way set-associative, physically addressed caches for instructions and data and on-chip instruction and data memory management units (MMUs). The MMUs contain 64-entry, two-way set-associative, data and instruction translation lookaside buffers (DTLB and ITLB) that provide support for demand-paged virtual memory address translation and variable-sized block translation.

The MPC603 has a selectable 32- or 64-bit data bus and a 32-bit address bus. The MPC603 interface protocol allows multiple masters to compete for system resources through a central external arbiter. The MPC603 provides a three-state coherency protocol that supports the Exclusive, Modified, and Invalid cache states. This protocol is a compatible subset of the MESI four-state protocol and operates coherently in systems that contain four-state caches. The MPC603 supports single-beat and burst data transfers for memory accesses; it also supports both memory-mapped I/O and I/O controller interface addressing.

The MPC603 uses an advanced, 3.3-V CMOS process technology and maintains full interface compatibility with TTL devices.

#### Block Diagram

Figure 3 provides a block diagram of the MPC603 that illustrates how the execution units — IU, FPU, BPU, LSU, and SRU — operate independently and in parallel.

The MPC603 provides address translation and protection facilities, including an ITLB, DTLB, and instruction and data BAT arrays. Instruction fetching and issuing is handled in the instruction unit. Translation of addresses for cache or external memory accesses are handled by the MMUs.

## MPC603e RISC Microprocessor

The MPC603e is a low-power implementation of the PowerPC RISC architecture. The MPC603e implements the 32-bit portion of the PowerPC architecture, which provides 32-bit effective addresses, integer data types of 8, 16, and 32 bits, and floating-point data types of 32 and 64 bits.

The MPC603e provides four software controllable power-saving modes. Three of the modes (the nap, doze, and sleep modes) are static in nature, and progressively reduce

the amount of power dissipated by the processor. The fourth is a dynamic power management mode that causes the functional units in the MPC603e to automatically enter a low-power mode when the functional units are idle without affecting operational performance, software execution, or any external hardware.

The MPC603e is a superscalar processor capable of issuing and retiring as many as three instructions per clock. Instructions can execute out of order for increased performance; however, the MPC603e makes completion appear sequential.

The MPC603e integrates five execution units — an integer unit (IU), a floating-point unit (FPU), a branch processing unit (BPU), a load/store unit (LSU), and a system register unit (SRU). The ability to execute five instructions in parallel and the use of simple instructions with rapid execution times yield high efficiency and throughput for MPC603e-based systems. Most integer instructions execute in one clock cycle. The FPU is pipelined so a single-precision multiply-add instruction can be issued every clock cycle.

The MPC603e provides independent on-chip, 16-Kbyte, four-way set-associative, physically addressed caches for instructions and data and on-chip instruction and data memory management units (MMUs). The MMUs contain 64-entry, two-way set-associative, data and instruction translation lookaside buffers (DTLB and ITLB) that provide support for demand-paged virtual memory address translation and variable-sized block translation.

The MPC603e has a selectable 32- or 64-bit data bus and a 32-bit address bus. The MPC603e interface protocol allows multiple masters to compete for system resources through a central external arbiter. The MPC603e provides a three-state coherency protocol that supports the exclusive, modified, and invalid cache states. This protocol is a compatible subset of the MESI (modified/exclusive/shared/invalid) four-state protocol and operates coherently in systems that contain four-state caches. The MPC603e supports single-beat and burst data transfers for memory accesses, and supports memory-mapped I/O accesses.

The MPC603e uses an advanced CMOS process technology and maintains full interface compatibility with TTL devices. The MPC603e is implemented in both a 2.5-V version (PID7V-603e) and a 3.3-V version (PID6-603e).

#### Block Diagram

Figure 4 provides a block diagram of the MPC603e that illustrates how the execution units — IU, FPU, BPU, LSU, and SRU — operate independently and in parallel.



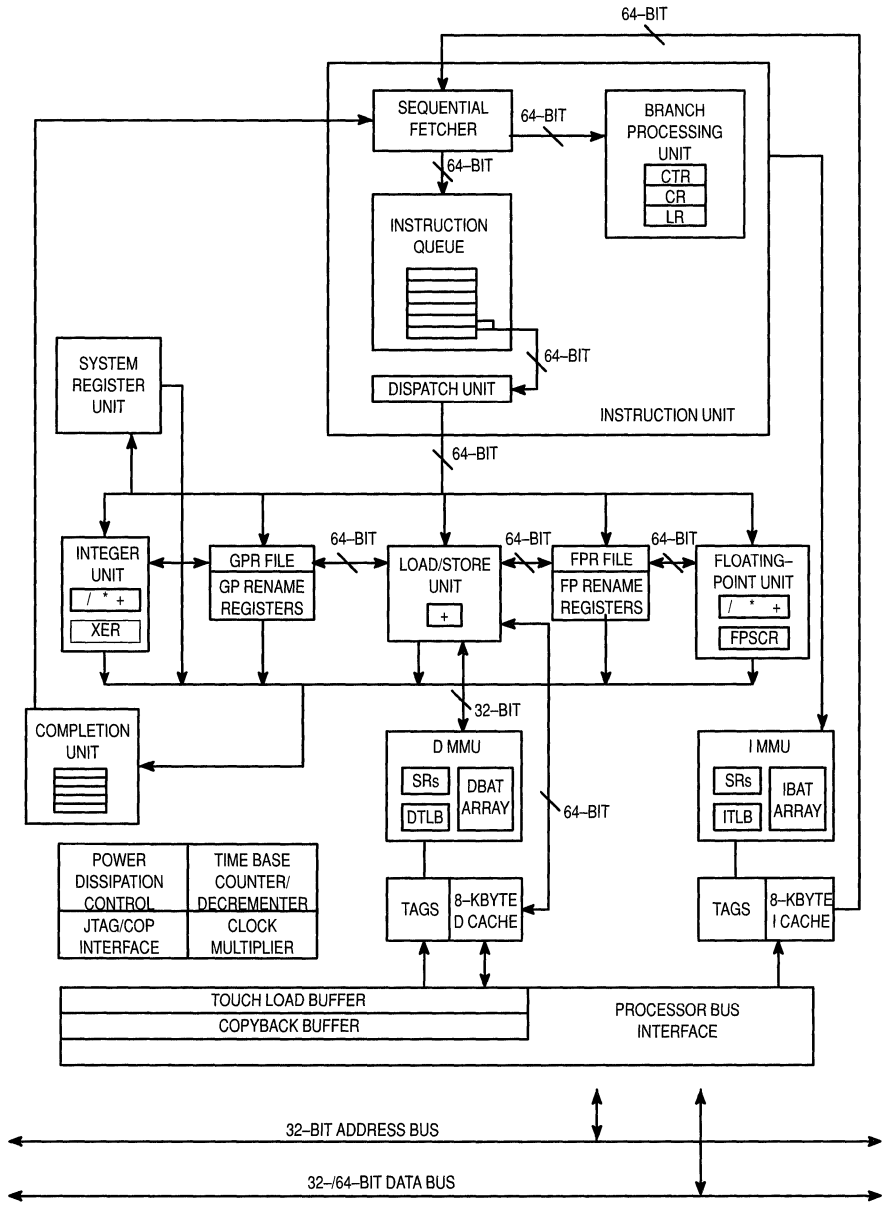


Figure 3. MPC603 Block Diagram



# MPC604 RISC Microprocessor

The MPC604 is an implementation of the PowerPC family of RISC microprocessors. The MPC604 implements the PowerPC architecture as it is specified for 32-bit addressing, which provides 32-bit effective (logical) addresses, integer data types of 8, 16, and 32 bits, and floating-point data types of 32 and 64 bits (single-precision and double-precision). For 64-bit PowerPC implementations, the PowerPC architecture provides additional 64-bit integer data types, 64-bit addressing, and related features.

The MPC604 is a superscalar processor capable of issuing four instructions simultaneously. As many as six instructions can finish execution in parallel. The MPC604 has six execution units that can operate in parallel—floating-point unit (FPU), branch processing unit (BPU), load/store unit (LSU), two single-cycle integer units (SCIUs), and one multiple-cycle integer unit (MCIU).

This parallel design, combined with the PowerPC architecture's specification of uniform instructions that allows for rapid execution times, yields high efficiency and throughput. The MPC604's rename buffers, reservation stations, dynamic branch prediction, and completion unit increase instruction throughput, guarantee in-order completion, and ensure a precise exception model. (Note that the PowerPC architecture specification refers to all exceptions as interrupts.)

The MPC604 has separate memory management units (MMUs) and separate 16-Kbyte on-chip caches for instructions and data. The MPC604 implements two 128-entry, two-way set (64-entry per set) associative translation lookaside buffers (TLBs), one for instructions and one for data, and provides support for demand-paged virtual memory address translation and variable-sized block translation. The TLBs and the cache use least-recently used (LRU) replacement algorithms.

The MPC604 has a 64-bit external data bus and a 32-bit address bus. The MPC604 interface protocol allows multiple masters to compete for system resources through a central external arbiter. Additionally, on-chip snooping logic maintains data cache coherency for multiprocessor applications. The MPC604 supports single-beat and burst data transfers for memory accesses and memory-mapped I/O accesses.

The MPC604 uses an advanced, 3.3-V CMOS process technology and is fully compatible with TTL devices.

## Block Diagram

Figure 5 provides a block diagram showing features of the MPC604. Note that this is a conceptual block diagram intended to show the basic features rather than an attempt to show how these features are physically implemented on the chip.

# MPC604e RISC Microprocessor

The MPC604e is an implementation of the PowerPC family of RISC microprocessors. The MPC604e implements the PowerPC architecture as it is specified for 32-bit addressing, which provides 32-bit effective (logical) addresses, integer data types of 8, 16, and 32 bits, and floating-point data types of 32 and 64 bits (single-precision and double-precision). For 64-bit PowerPC implementations, the PowerPC architecture provides additional 64-bit integer data types, 64-bit addressing, and related features.

The MPC604e is a superscalar processor capable of issuing four instructions simultaneously. As many as seven instructions can finish execution in parallel. The MPC604e has seven execution units that can operate in parallel—floating-point unit (FPU), branch processing unit (BPU), condition register unit (CRU), load/store unit (LSU), two single-cycle integer units (SCIUs), and one multiple-cycle integer unit (MCIU).

This parallel design, combined with the PowerPC architecture's specification of uniform instructions that allows for rapid execution times, yields high efficiency and throughput. The MPC604e's rename buffers, reservation stations, dynamic branch prediction, and completion unit increase instruction throughput, guarantee in-order completion, and ensure a precise exception model. (Note that the PowerPC architecture specification refers to all exceptions as interrupts.)

The MPC604e has separate memory management units (MMUs) and separate 32-Kbyte on-chip caches for instructions and data. The MPC604e implements two 128-entry, two-way set associative translation lookaside buffers (TLBs), one for instructions and one for data, and provides support for demand-paged virtual memory address translation and variable-sized block translation. The TLBs and the cache use least-recently used (LRU) replacement algorithms.

The MPC604e has a 64-bit external data bus and a 32-bit address bus. The MPC604e interface protocol allows multiple masters to compete for system resources through a central external arbiter. Additionally, on-chip snooping logic maintains data cache coherency for multiprocessor applications. The MPC604e supports single-beat and burst data transfers for memory accesses and memory-mapped I/O accesses.

The MPC604e uses an advanced, 2.5-V CMOS process technology and is fully compatible with TTL devices.

## Block diagram

Figure 6 provides a block diagram of the MPC604e.

Figure 5. MPC604 Block Diagram

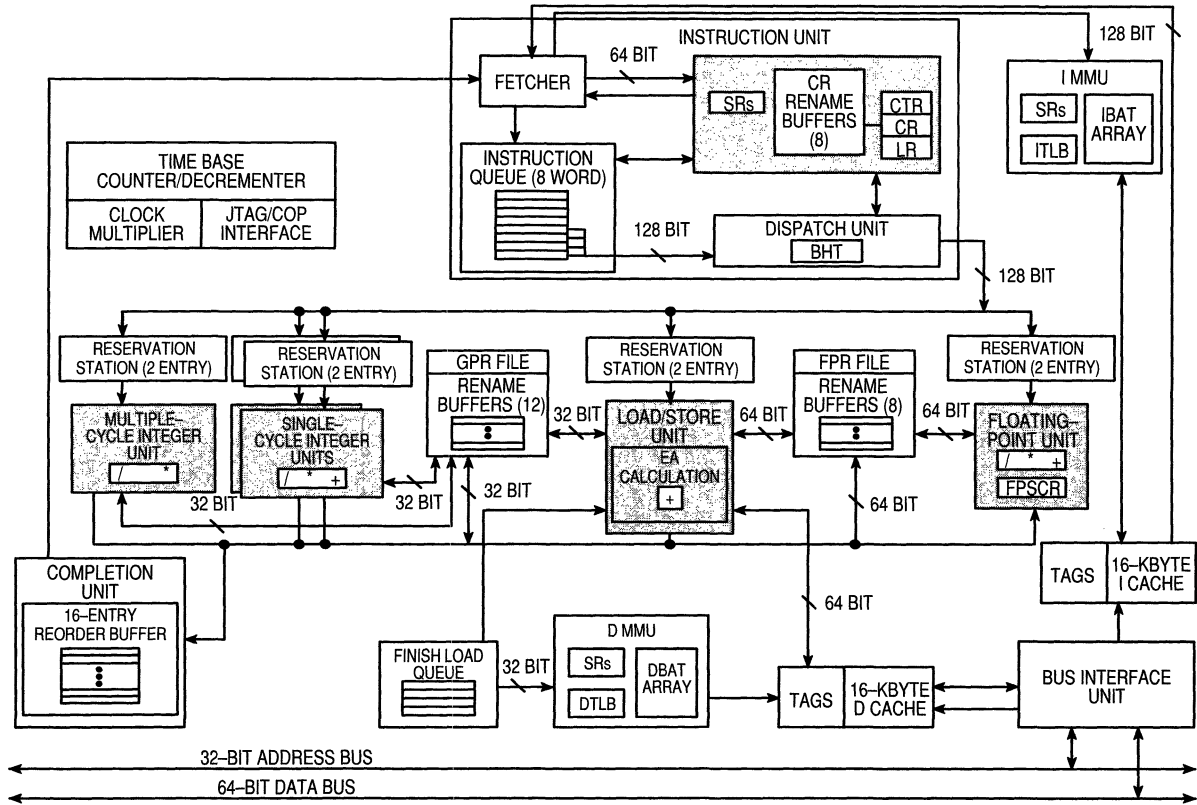
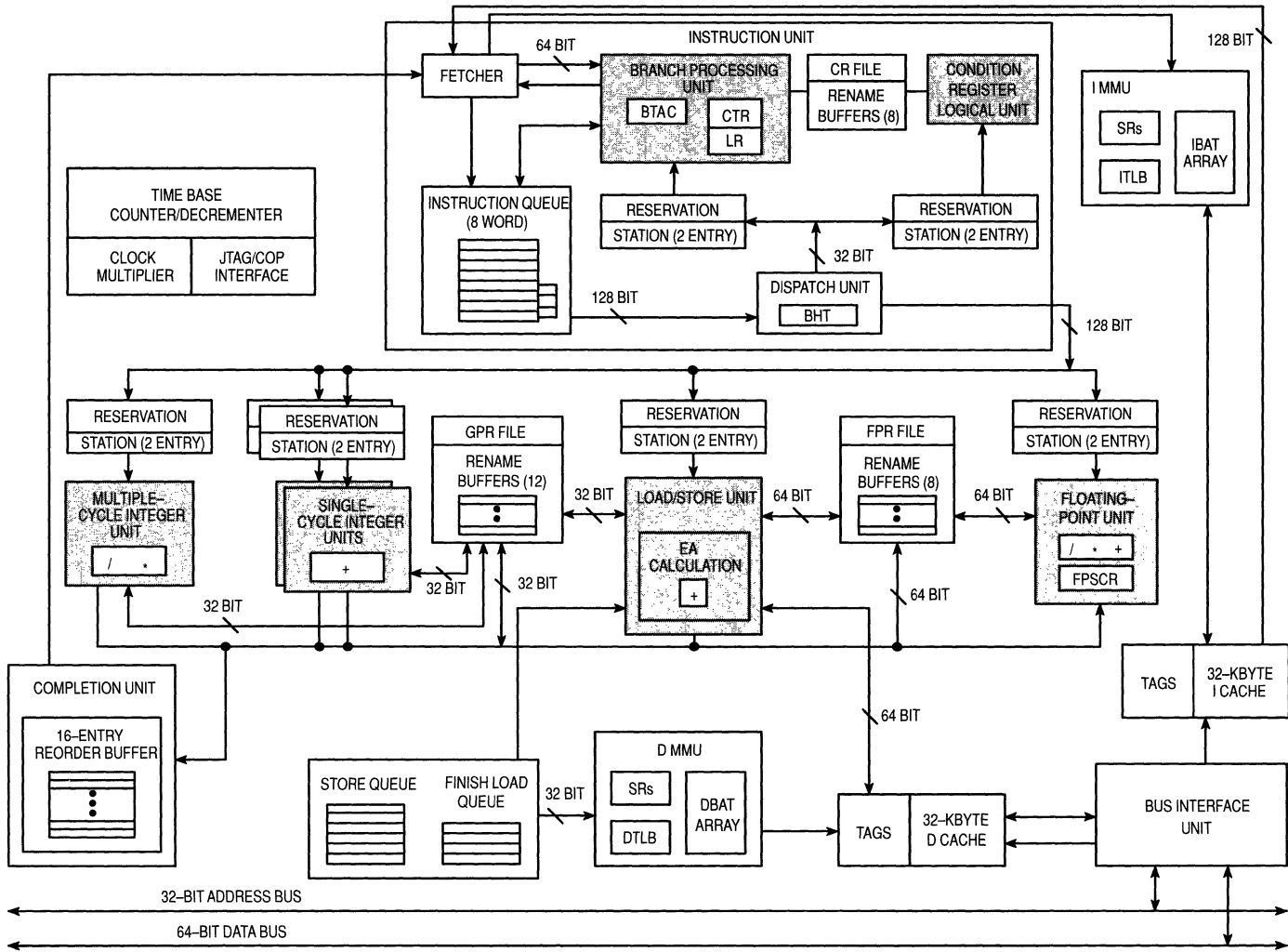


Figure 6. MPC604e Block Diagram



The PowerPC RISC Family Microprocessor

## New Features of the MPC604e

Features of the MPC604e that are not implemented in the MPC604 are as follows:

- Additional special-purpose registers
  - HID1 provides four read-only PLL\_CFG bits for indicating the processor/bus clock ratio.
  - Three additional registers support the performance monitor—MMCR1 is a second control register that includes bits to support the use of two additional counter registers, PMC3 and PMC4.
- Instruction execution
  - Separate units for branch and condition register (CR) instructions. The BPU is now split into a CR logical unit and a branch unit, which makes it possible for branch instructions to execute and resolve before preceding CR logical instructions. The MPC604e can still only dispatch one CR logical or branch instruction per cycle, but it can execute both branch and CR logical instructions at the same time.
  - Branch correction in decode stage. Branch correction in the decode stage can now predict branches whose target is taken from the count or link registers if no updates of the count and link register are pending. This saves at least one cycle on branch correction when the **mtspr** instruction can be sufficiently separated from the branch that uses the SPR as a target address.
  - Ability to disable the branch target address cache (BTAC)—HID0[30] has been defined to allow the BTAC to be disabled. When HID0[30] is set, the BTAC contents are invalidated and the BTAC behaves as if it were empty. New entries cannot be added until the BTAC is enabled.
- Improvements to cache implementation
  - 32-Kbyte split data and instruction caches. Like the 604, both caches are four-way set associative; however, each cache has twice as many sets, logically separated into 128 sets of odd lines and 128 sets of even lines.
  - Data cache line-fill buffer forwarding. In the 604 only the critical double word of a burst operation was made available to the requesting unit at the time it was burst into the line-fill buffer. Subsequent data was unavailable until the cache block was filled. On the MPC604e, subsequent data is also made available as it arrives in the line-fill buffer.
  - Additional cache copyback buffers. The MPC604e implements three copyback write buffers (as opposed to one in the 604). Having multiple copyback buffers provides the ability for certain instructions to take fuller advantage of the pipelined system bus to provide more efficient handling of cache copyback, block invalidate operations caused by the data cache block flush (**dcbf**) instruction, and cache block clean operations resulting from the data cache block store (**dcbst**) instruction.
- Coherency support for instruction fetching. Instruction fetching coherency is controlled by HID0[23]. In the default mode, HID0[23] is 0,  $\overline{\text{GBL}}$  is not asserted for instruction accesses, as is the case with the 604. If the bit is set, and instruction translation is enabled ( $\text{MSR}[\text{IR}] = 1$ ), the  $\overline{\text{GBL}}$  signal is set to reflect the M bit for this page or block. If instruction translation is disabled ( $\text{MSR}[\text{IR}] = 0$ ), the  $\overline{\text{GBL}}$  signal is asserted.
- System interface operation
  - The MPC604e has the same pin configuration as the MPC604; however, on the MPC604e  $V_{\text{DD}}$  and  $\text{AV}_{\text{DD}}$  must be connected to 2.5 Vdc and  $\text{OV}_{\text{DD}}$  must be connected to 3.3 Vdc. The MPC604e uses split voltage planes, and for replacement compatibility, MPC604/MPC604e designs should provide both 2.5-V and 3.3-V planes and the ability to connect those two planes together and disable the 2.5-V plane for operation with an MPC604.
  - Support for additional processor/bus clock ratios (5:2 and 4:1). Configuration of the processor/bus clock ratios is displayed through a new MPC604e-specific register, HID1.
  - To support the changes in the clocking configuration, different precharge timings for the  $\overline{\text{ABB}}$ ,  $\overline{\text{DBB}}$ ,  $\overline{\text{ARTRY}}$ , and  $\overline{\text{SHD}}$  signals are implemented internally by the processor. The precharge timings for  $\overline{\text{ARTRY}}$  and  $\overline{\text{SHD}}$  can be disabled by setting HID0[7].
  - No-DRTRY mode. In addition to the normal and fast L2 modes implemented on the 604, a no-DRTRY mode is implemented on the MPC604e that improves performance on read operations for systems that do not use the  $\overline{\text{DRTRY}}$  signal. No-DRTRY mode makes read data available to the processor one bus clock cycle sooner than in normal mode. In no-DRTRY mode, the  $\overline{\text{DRTRY}}$  signal is no longer sampled as part of a qualified bus grant.
- Full hardware support for little-endian accesses. Little-endian accesses take alignment exceptions for only the same set of causes as big-endian accesses. Accesses that cross a word boundary require two accesses with the lower-addressed word accessed first.
- Additional enhancements to the performance monitor.

# MPC620 RISC Microprocessor

The MPC620 is an implementation of the PowerPC™ family of RISC microprocessors. The MPC620 implements the PowerPC architecture as it is specified for 64-bit addressing, which provides 64-bit effective (logical) addresses, integer data types of 8, 16, 32, and 64 bits, and floating-point data types of 32 and 64 bits (single-precision and double-precision). The MPC620 is software compatible with the 32-bit versions of the PowerPC microprocessor family.

The MPC620 is a superscalar processor capable of issuing four instructions simultaneously. As many as six instructions can finish execution in parallel. The MPC620 has six execution units that can operate in parallel — floating-point unit (FPU), branch processing unit (BPU), load/store unit (LSU), two single-cycle integer units (SCIUs), and one multiple-cycle integer unit (MCIU).

This parallel design, combined with the PowerPC architecture's specification of uniform instructions that allows for rapid execution times, yields high efficiency and throughput. The MPC620's rename buffers, reservation stations, dynamic branch prediction, and completion unit increase instruction throughput, guarantee in-order completion, and ensure a precise exception model.

The MPC620 has separate memory management units (MMUs) and separate 32-Kbyte on-chip caches for instructions and data. The MPC620 implements a 128-entry, two-way set-associative translation lookaside buffer (TLB) for instructions and data, and provides support for demand-paged virtual memory address translation and variable-sized block translation. The TLB and the cache use least-recently used (LRU) replacement algorithms.

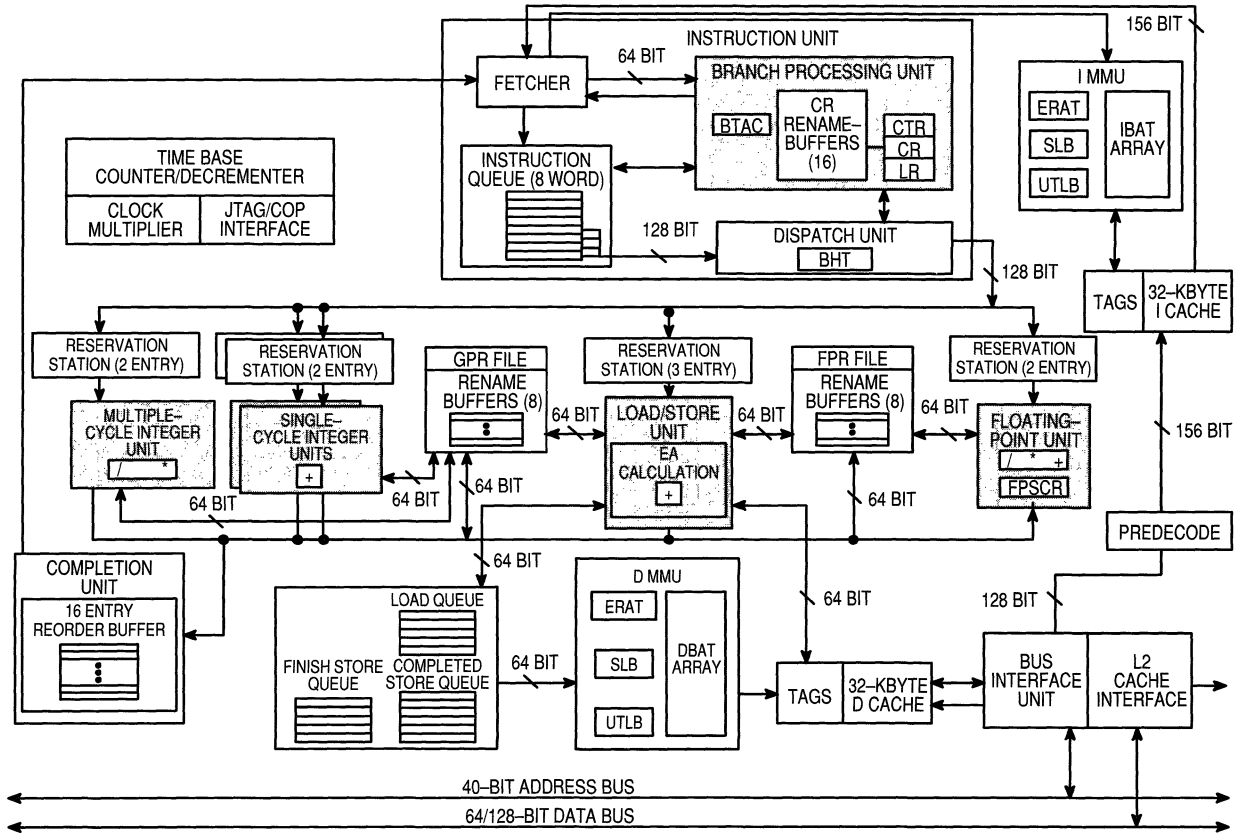
The MPC620 has a 40-bit address bus, and can be configured with either a 64- or 128-bit data bus. The MPC620 interface protocol allows multiple masters to compete for system resources through a central external arbiter. Additionally, on-chip snooping logic maintains data cache coherency for multiprocessor applications. The MPC620 supports single-beat and burst data transfers for memory accesses and memory-mapped I/O accesses.

The MPC620 uses an advanced, 3.3-V CMOS process technology and is compatible with 3.3-V CMOS devices.

## Block Diagram

Figure 7 provides a block diagram showing features of the MPC620. Note that this is a conceptual block diagram intended to show the basic features rather than an attempt to show how these features are physically implemented on the chip.

Figure 7. MPC620 Block Diagram





# MPC105 PCI Bridge/Memory Controller

The MPC105 PCI bridge/memory controller (PCIB/MC) provides a PowerPC reference platform-compliant bridge between the PowerPC microprocessor family and the peripheral component interconnect (PCI) bus. PCI support allows system designers to rapidly design systems using peripherals already designed for PCI and the other standard interfaces available in the personal computer hardware environment. The MPC105 integrates secondary cache control and a high-performance memory controller that supports DRAM, SDRAM, ROM, and Flash ROM. The MPC105 uses an advanced, 3.3-V CMOS process technology and is fully compatible with TTL devices.

The MPC105 provides an integrated high bandwidth, high performance, TTL-compatible interface between a 60x processor, a secondary (L2) cache or secondary 60x processor, the PCI bus, and main memory.

The MPC105 supports a programmable interface to a variety of PowerPC microprocessors operating at various bus speeds. The 60x processor interface uses a subset of the 60x bus protocol, which enables the interface between the processor and MPC105 to be optimized for performance. The MPC105's 60x interface allows for a variety of system configurations by providing support for either a direct-mapped, lookaside, L2 cache or a secondary 60x processor. The L2 cache interface generates the arbitration and support signals necessary to maintain a write-through or

write-back L2 cache. The L2 cache interface supports either burst SRAMs or asynchronous SRAMs, and L2 data a per-byte basis. The MPC105 features on-chip byte decoding for L2 data write enables or can be configured to use external logic for data write enable generation.

The PCI interface connects the processor and memory buses to the PCI bus, to which I/O components are connected, without the need for "glue" logic. This interface acts as both a master and slave device.

The memory interface controls processor and PCI interactions to main memory. It is capable of supporting a variety of DRAM or SDRAM, and ROM or Flash ROM configurations as main memory. The maximum supported memory size is 1 Gbyte of DRAM or SDRAM, with 16 Mbytes of ROM or 1 Mbyte of Flash ROM.

The MPC105 provides hardware support for four levels of power reduction; the doze, nap, and sleep modes are invoked by register programming, and the suspend mode is invoked by assertion of an external signal. The design of the MPC105 is fully static, allowing internal logic states to be preserved during all power saving modes. The following sections describe the programmable power modes provided by the MPC105.

## Block Diagram

Figure 8 shows the MPC105 in a typical system implementation. The major functional units within the MPC105 are also shown in Figure 1. Note that this is a conceptual block diagram intended to show the basic features rather than an attempt to show how these features are physically implemented on the device.

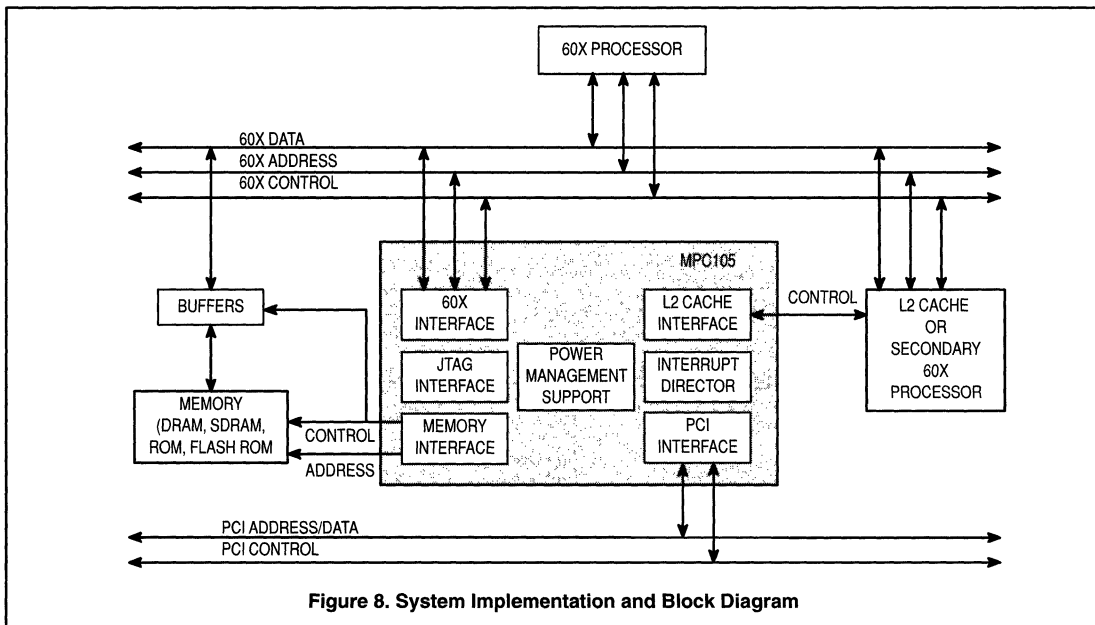


Figure 8. System Implementation and Block Diagram

# MPC106 PCI Bridge/Memory Controller

The MPC106 provides a PowerPC common hardware reference platform (CHRP) compliant bridge between the PowerPC microprocessor family and the Peripheral Component Interconnect (PCI) bus. PCI support allows system designers to rapidly design systems using peripherals already designed for PCI and the other standard interfaces available in the personal computer hardware environment. The MPC106 integrates secondary cache control and a high-performance memory controller. The MPC106 uses an advanced, 3.3-V CMOS process technology and is fully compatible with TTL devices.

The MPC106 provides an integrated high-bandwidth, high-performance, TTL-compatible interface between a 60x processor, a secondary (L2) cache or secondary 60x processor, the PCI bus, and main memory.

## 60x Processor Interface

The MPC106 supports a programmable interface to a variety of PowerPC microprocessors operating at select bus speeds. The 60x processor interface of the MPC106 uses a subset of the 60x bus protocol, supporting single-beat and burst data transfers. The address bus is 32 bits wide and the data bus is 64 bits wide. The address and data buses are decoupled to support pipelined transactions. PCI bus accesses to system memory space are passed to the 60x processor bus for snooping purposes. Two signals on the MPC106, LBCLAIM, and DBGLB, are provided for an optional local bus slave. The local bus slave must be capable of generating AACK and TA signals to interact with the 60x processor(s). Depending on the system implementation, the processor(s) may operate at the PCI bus clock rate, or at two or three times the PCI bus clock rate. The bus is synchronous, with all timing relative to the rising edge of the bus clock.

## L2 Cache/Multiple Processor Interface

The MPC106 provides support for the following configurations of 60x processors and L2 cache:

- A single 60x processor with no L2 cache
- A single 60x processor plus a direct-mapped, lookaside, L2 cache
- A single 60x processor plus an external L2 cache controller or integrated L2 cache module such as the Motorola MPC2604GA integrated L2 lookaside cache
- Two 60x processors with no L2 cache
- Two 60x processors plus an external L2 cache controller or integrated L2 cache module such as the Motorola MPC2604GA integrated L2 lookaside cache

The internal L2 cache controller generates the arbitration and support signals necessary to maintain a write-through or write-back L2 cache. The internal L2 cache controller supports either asynchronous SRAMs, pipelined burst SRAMs, or synchronous burst SRAMs, using byte parity for data error detection. When a second 60x processor is used, three signals of the L2 interface ( $\overline{BR1}$ ,  $\overline{BG1}$ , and  $\overline{DBG1}$ ) change their functions to allow for arbitration between the 60x processors. All 60x interface signals of the MPC106, except the bus request, bus grant, and data bus grant signals, are shared by the 60x processors. When an external L2 controller (or integrated L2 cache module) is used, three signals of the L2 interface ( $\overline{BRL2}$ ,  $\overline{BGL2}$ , and  $\overline{DBGL2}$ ) change their functions to allow the MPC106 to arbitrate between the external cache and the 60x processor(s).

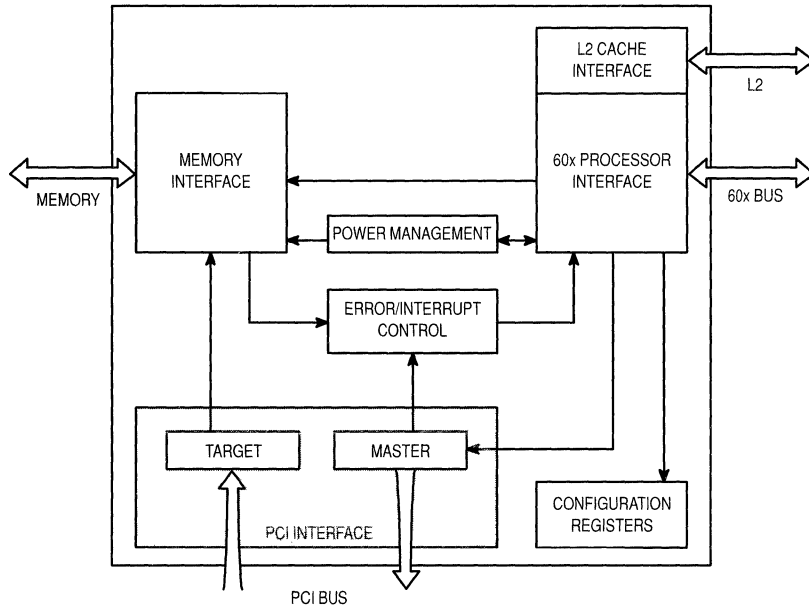
## Memory Interface

The memory interface controls processor and PCI interactions to main memory and is capable of supporting a variety of DRAM, or extended data-out (EDO) DRAM and ROM or Flash ROM configurations as main memory. The maximum supported memory size is 1 Gbyte of DRAM or EDO DRAM, with 16 Mbytes of ROM or Flash ROM. The memory controller of the MPC106 supports the various memory sizes through software initialization of on-chip configuration registers. Parity or ECC is provided for error detection.

## PCI Interface

The MPC106's PCI interface is compliant with the PCI *Local Bus Specification, Revision 2.1*, and follows the guidelines in the *PCI System Design Guide, Revision 1.0* for host bridge architecture. The PCI interface connects the processor and memory buses to the PCI bus, to which I/O components are connected. The PCI bus uses a 32-bit multiplexed address/data bus, plus various control and error signals.

Figure 9 shows the major functional units within the MPC106. Note that this is a conceptual block diagram intended to show the basic features rather than an attempt to show how these features are physically implemented on the device.



**Figure 9. MPC106 Block Diagram**



# Single-Chip Microcontrollers (CSIC)

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## In Brief . . .

Motorola offers the most comprehensive selection of high-performance single-chip control systems available from a single source. Microcontroller device families range from industry-standard 8-bit controllers to state-of-the-art 16- and 32-bit modular controllers. Within the price and performance categories of each family, there are a variety of on-chip capabilities to match specific applications.

Motorola device families are structured so that upward migration need not involve complete code development. The M68HC11 Family is upward code compatible with M6800 and M6801 software, while the M68HC16 family is source-code compatible with the M68HC11 family. Motorola's newest 8-bit MCU product line, the M68HC08 family, is fully upward object code compatible with the M68HC05 and M6805 families. In addition, M68300 and M68HC16 devices share standard internal modules and bus configurations.

	<b>Page</b>
M68HC05 CSIC Family .....	2.5-2
M68HC08 Family .....	2.5-13
Development Tools .....	2.5-14
On-Line Help .....	2.5-23

# M68HC05 CSIC Family

It all started with the 68HC05 Family, and Motorola's CSIC (Customer-Specified Integrated Circuits) approach to microcontroller design. Today, customers can select from over 70 mask ROM 68HC05 devices and over 30 one-time programmable (OTP) 68HC705 devices — and that number is growing all the time, as Motorola continues to develop derivatives of the 68HC05 based on customer demand.

With so many standard 68HC05 microcontrollers from which to choose, most customers will find the right device for an application among these existing devices. For some high-volume applications, however, a customer may opt for Motorola to develop a new derivative to meet an application's precise requirements. The result is a new microcontroller which can then be added to the selection of standard devices.

## M68HC05 Industry Solutions

Motorola's 68HC05 and 68HC08 Families consist of a variety of microcontroller designs to meet the requirements of a broad range of applications. The 68HC05 Family, already over 100 devices strong, offers a wide range of standard products from which to choose, while the flagship 68HC08 offers a large library of modules from which derivatives can be developed.

## 68HC05 General-Purpose Microcontrollers

**68HC05 C-Family.** These flexible, general-purpose devices feature a wide variety of memory options capable of handling complex programs. On-chip SCI provides asynchronous communications, with software-selectable baud rates from 75 Hz to 131 kHz. The high-speed, synchronous 4-wire serial system SPI is ideal for driving off-chip displays and peripherals.

All C-Family devices include a powerful 16-bit free-running programmable counter in conjunction with input capture and output compare functions for simultaneous input waveform measurement and output waveform generation. A watchdog timer guards against runaway software in noisy environments.

The high-packing density of Motorola's HCMOS process allows standard devices to run at bus frequencies up to 2.1 MHz. Motorola also offers high-speed versions which run at frequencies up to 4.2 MHz from an 8.4 MHz crystal or external clock. Low-voltage versions are available for applications requiring extremely low power consumption to extend battery life or minimize heat dissipation.

**68HC05 J-Family.** This 20-pin family provides a low-cost, low pin count, 8-bit upgrade for existing 4-bit applications. It combines a powerful 68HC05 CPU with a flexible, 15-stage multifunction timer and real-time interrupt capability.

**68HC05 K-Family.** Our lowest-cost family offers a 16-pin count and is appropriate for logic replacement.

**68HC05 P-Family.** Born out of the CSIC design concept, this family offers an extremely cost-competitive 28-lead

family of microcontrollers with a variety of ROM sizes and special features such as Serial Input/Output Port (SIOP) to control display drivers and communicate with other peripherals. Other options include A/D input and on-chip EEPROM for non-volatile data storage. Low-voltage and high-speed versions are also available.

The flagship 68HC(7)08XL36 OTP and ROM versions are the first two devices in the 68HC08 Family and are intended for general purpose uses.

## Low-Voltage Microcontrollers

The 68HC05 Family has been capable of 3.0 V operation since 1980 and includes some 2.2 V selections. Recently, Motorola announced several 68HC05 microcontrollers capable of 1.8 Vdc and 500 kHz operation. This new low-voltage capability affords a greater than threefold power savings over 3.0 V versions of the same chips, a significant design consideration for any portable electronic application. The new devices are collectively designated 68HCL05 and include the following versions: 68HCL05C4, C8, C12, J1A, K0, P1, and P4. They are designed to provide lower-power control technology to accommodate trends in portable applications toward compactness, lightweight design, and extended battery life.

## Automotive

**68HC05 B-Family.** EEPROM memory in these devices makes it possible to store information that must be retained after the power is removed. Applications include electric seat control (storage of seat positions) and audio systems (storage of radio stations).

**68HC05 C- and D-Families.** These general-purpose microcontrollers are used for cruise control, ignition systems, and in-car entertainment systems.

**68HC05 J-, K-, and P-Families.** With their low pin count and low cost, these devices are ideal for automotive applications such as car alarms, power windows, keyless entry, and air bags.

**68HC05 V- and X-Families.** Both these groups contain integrated automotive multiplex interfaces that allow them to talk to other electronic modules within a vehicle. The V series adds an on-chip voltage regulator.

## Computer

**68HC05 BD-Family.** These devices are ideal for computer monitor applications. They include a horizontal and vertical sync processor as well as 16 channels of pulse-width modulation.

**68HC05 C-Family.** These are general purpose devices for keyboard and monitor control.

**68HC05 J-, P-, and E-Families.** These low-cost, low pin count devices are appropriate for applications like a cordless PC mouse and trackball.

## Consumer

**68HC05 C- and D-Families.** The multiple communication lines (I/O ports, SCI and SPI) and free-running timer in this group of devices make it possible to execute several tasks in parallel. These features are used in consumer products like CD players, automotive entertainment systems, and remote controls.

**68HC05 J-, K-, and P-Families.** The free-running timer in these cost-effective microcontrollers allows multitasking in applications such as washing machines, oven controls, and remote controls.

**68HC05 L-Family.** These low-power, small-footprint devices can drive large LCD displays, making them ideal for hand-held consumer products like portable CD players.

## Industrial

**68HC05 B-Family.** On-chip features include EEPROM; 8-channel, 8-bit A/D converter; and Pulse Length Modulated outputs. Typical industrial applications include Programmable Logic Controllers (PLC) and data acquisition systems.

**68HC05 C- and D-Families.** These general-purpose devices can be used in applications such as process control systems where multiple I/O lines and LED outputs are required.

**68HC05 J- and P-Families.** These devices are popular in low-cost industrial applications such as smoke detectors, security devices, thermostats, and furnace ignition systems.

**68HC05 L-Family.** Multi-port controllers with LCD driver, 16-bit timer and watchdog timer on board. Excellent for display panels requiring tone output and low power consumption such as thermostats and alarms.

**68HC705MC4.** This device is intended for use in industrial motor control and power supply applications.

**68HC05 X-Family.** These devices have Controlled Area Network (CAN) controllers with 4K thru 32K ROM for integrated messaging on factory automation, sensor, and switch applications.

## Telecommunications

**68HC05 B-Family.** These devices can store user-programmable telephone numbers in 256 bytes of non-volatile EEPROM memory. They can also communicate with analog inputs like battery life in hand-held equipment, using the A/D module. The D/A module can be used to control analog outputs such as telephone volume and line cards.

**68HC05 C-Family.** This group of microcontrollers has proven useful as a general-purpose device for communications applications.

**68HC05 E-Family.** Like the 68HC05 B-Series devices, E-Series devices are ideal for number storage and keyboard interrupt applications.

**68HC05 F-Family.** These devices — except for the F5, which features an integrated DTMF receiver — include an on-chip Dual-Tone Multi-Frequency Generator (DTMG) for digital transmission and reception, as well as an LED drive for user information. These features make the F-Family suitable for a number of telecommunications applications, including auto dialing, number storage, and display control.

**68HC05 J- and P-Families.** These low pin count, low-cost microcontrollers have a variety of telecommunications uses, with features ranging from EEPROM to multifunction timers.

**68HC05 L-Family.** With its large LCD driving capability and low power consumption, this series is well-suited to applications in hand-held communication equipment. The on-chip tone generator and display functions can be used in pager systems to alert users to incoming messages.

## Television and Video

**68HC05 B-Family.** These devices are ideal for EEPROM storage, with 256 bytes of EEPROM to store TV or satellite channel frequencies and preset volume or brightness levels. Features include Analog-to-Digital (A/D) conversion and PWM.

**68HC05 C- and D-Families.** With up to 32K of user ROM, these devices can be used in the television and video market as general-purpose microcontrollers.

**68HC05 CC-Family.** Evolved from the T-Series, CC-Series devices feature closed-caption Data Slicer (DSL) and enhanced OSD features for decoding and displaying closed captions.

**68HC05CO.** This device has no on-chip user ROM, but is capable of addressing up to 64K of external memory, making it ideal for applications that require large amounts of operating code, like televisions. The I<sup>2</sup>C bus module and 4 MHz internal bus speed also allow interconnection with standard TV peripherals.

**68HC05 K- and RC-Families.** These devices are used in remote control applications.

**68HC05 T-Family.** All T-Family devices have On Screen Display (OSD) modules that can overlay graphical images onto television screens. They also contain D/A converters that can drive analog outputs like volume control, and A/D converters that can be used to automatically adjust the fine tuning. Some members of the T-Series have I<sup>2</sup>C interfaces that can communicate with industry-standard TV peripherals.

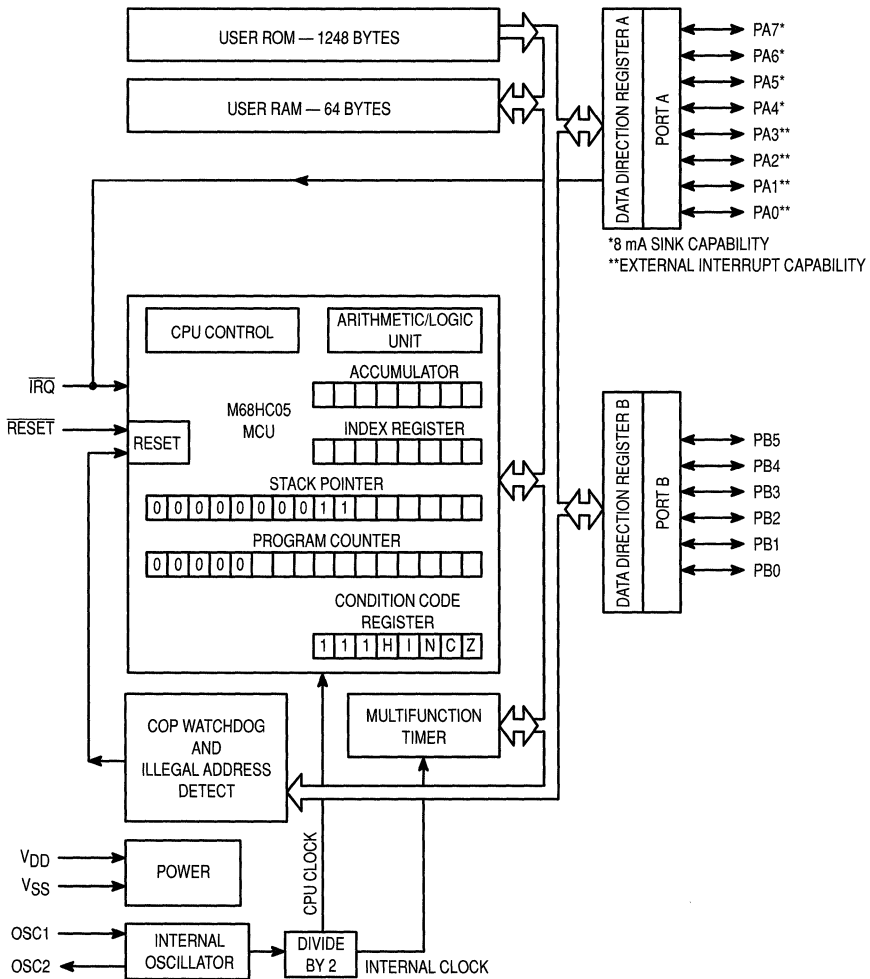


Figure 1. MC68HC05J1A Block Diagram



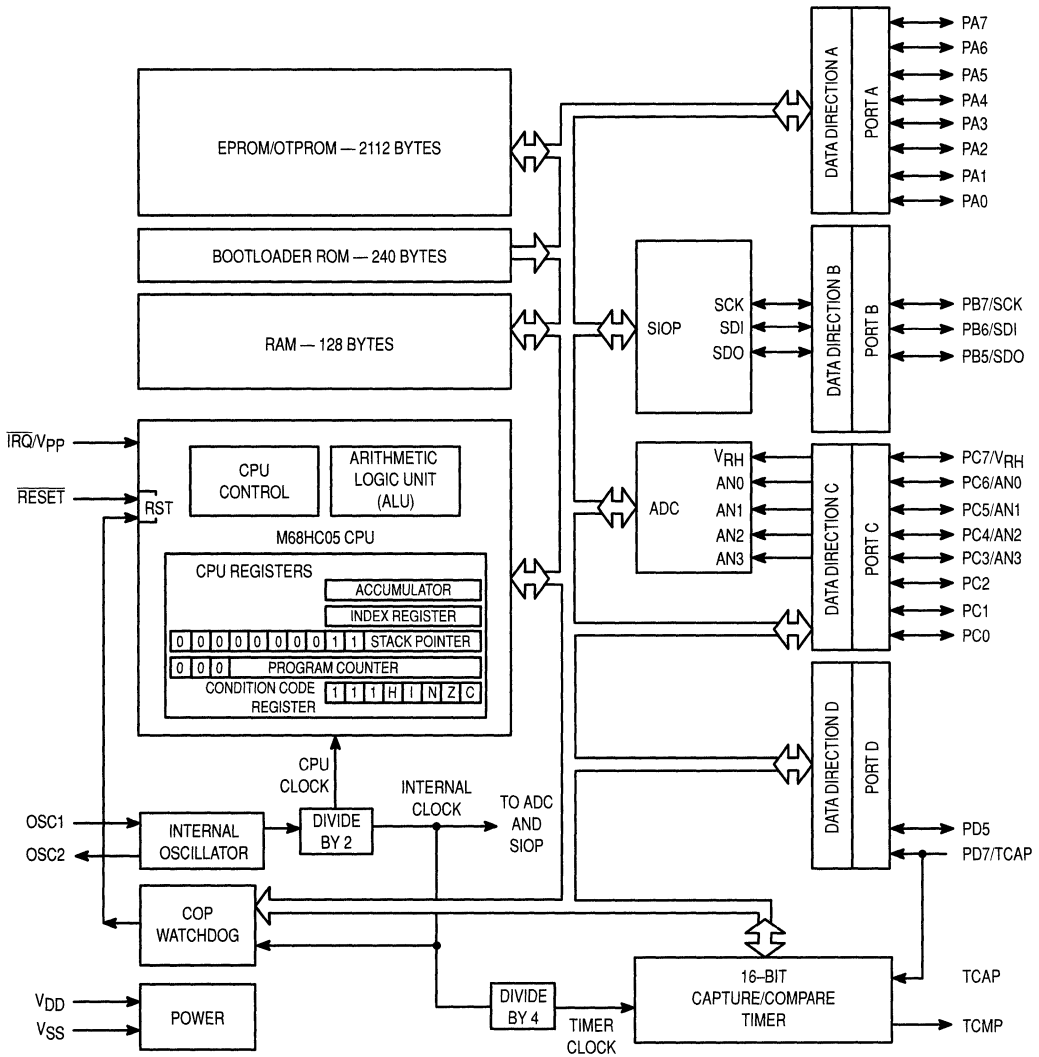


Figure 2. MC68HC705P9 Block Diagram

# 68HC05 MICROCONTROLLERS

All 68HC05 products have a standard operating voltage range from 3 V to 5.5 V unless noted in Comments.

All 68HC05 products have a standard operating temperature range from 0 – 70°C.

Contact a Motorola Sales Office for availability of extended temperature versions.

**Table 1. 68HC05 Microcontrollers**

Motorola Part Number	ROM (Bytes)	RAM (Bytes)	EEPROM (Bytes)	Timer	Serial	A/D	PWM	Display Drive	I/O	COP	Comments	Packages
MC68HC05B4	4K	176		16-bit: (2IC, 2OC)	SCI+	8 ch (8-bit)	2 ch (8-bit)		24 i/o 8 i 2 o	✓		56 SDIP – B 52 PLCC – FN 64 QFP – FU
MC68HC05B6	6K	176	256	16-bit: (2IC, 2OC)	SCI+	8 ch (8-bit)	2 ch (8-bit)		24 i/o 8 i 2 o	✓	On-Chip Charge Pump EEPROM Write Protect	56 SDIP – B 52 PLCC – FN 64 QFP – FU
MC68HC05B8	7.25K	176	256	16-bit: (2IC, 2OC)	SCI+	8 ch (8-bit)	2 ch (8-bit)		24 i/o 8 i 2 o	✓	On-Chip Charge Pump EEPROM Write Protect	56 SDIP – B 52 PLCC – FN 64 QFP – FU
MC68HC05B16	15K	352	256	16-bit: (2IC, 2OC)	SCI+	8 ch (8-bit)	2 ch (8-bit)		24 i/o 8 i 2 o	✓	On-Chip Charge Pump EEPROM Write Protect	56 SDIP – B 52 PLCC – FN 64 QFP – FU
MC68HC05BD3	3.75K	128		MFT, RTI	I <sup>2</sup> C		16 ch (8-bit)		24 i/o	✓	Horizontal and Vertical Sync Signal Processor	40 DIP – P 42 SDIP – B
MC68HC05BD5	7.75K	256		MFT, RTI	I <sup>2</sup> C		16 ch (8-bit)		24 i/o	✓	Horizontal and Vertical Sync Signal Processor	40 DIP – P 42 SDIP – B
MC68HC05C4A	4K	176		16-bit: (1IC, 1OC)	SPI SCI				24 i/o 7 i	✓	KBI (8 pins) 1 High Current Pin (5 mA sink) Mask Option Pullups High Speed Option (HSC05C4A) Low Power Option (HCL05C4A) (1.8 V minimum)	40 DIP – P 44 PLCC – FN 44 QFP – FB 42 SDIP – B
MC68HC05C5	5K	176	128	16-bit: (1IC, 1OC)	SIOP				32 i/o	✓	8 High Current Pins (10 mA sink) LVPI, On-Chip Charge Pump	40 DIP – P 44 PLCC – FN
MC68HC05C8A	8K	176		16-bit: (1IC, 1OC)	SPI SCI				24 i/o 7 i	✓	KBI (8 pins) 1 High Current Pin (5 mA sink) Mask Option Pullups High Speed Option (HSC05C8A) Low Power Option (HCL05C8A) (1.8 V minimum)	40 DIP – P 44 PLCC – FN 44 QFP – FB 42 SDIP – B
MC68HC05C9A	16K	352		16-bit: (1IC, 1OC)	SPI SCI				24 i/o 7 i	✓	KBI (8 pins) 1 High Current Pin (5 mA sink) Mask Option Pullups High Speed Option (HSC05C9A) Low Power Option (HCL05C9A)	40 DIP – P 44 PLCC – FN 44 QFP – FB 42 SDIP – B
MC68HC05C12	12K	176		16-bit: (1IC, 1OC)	SCI SPI				24 i/o 7 i	✓	1 High Current Pin (20 mA sink) KBI (8 pins) Mask Option Pullups (8 pins) High Speed Option (HSC05C12) Low Power Option (HCL05C12): (1.8 V minimum)	40 DIP – P 44 PLCC – FN 44 QFP – FB 42 SDIP – B
MC68HC05CJ4	4K	224		16-bit: (1IC, 1OC) MFT	SPI SCI I <sup>2</sup> C				24 i/o	✓	I <sup>2</sup> C (Slave Only)	44 QFP – FB
MC68HC05D9	16K	352		16-bit: (1IC, 1OC)	SCI		5 ch (6-bit)		31 i/o	✓	8 High Current Pins (25 mA sink) 30 kHz PWM	40 DIP – P 44 PLCC – FN
MC68HC05D24	24K	352		16-bit: (1IC, 1OC)	SCI		5 ch (6-bit)		31 i/o	✓	8 High Current Pins (24 mA sink) 30 kHz PWM	40 DIP – P 44 PLCC – FN
XC68HC05D32	32K	352		16-bit: (1IC, 1OC)	SCI		5 ch (6-bit)		31 i/o	✓	8 High Current Pins (24 mA sink) 30 kHz PWM	40 DIP – P 44 PLCC – FN
MC68HC05E1	4K	368		MFT, RTI					20 i/o	✓	32 kHz PLL Clock Synthesizer	28 DIP – P 28 SOIC – DW
MC68HC05E6	6K	128	160	16-bit: (1IC, 1OC) MFT, RTI		4 ch (8-bit)			32 i/o 4 i	✓	KBI (8 pins) Pin for External LVI	44 QFP – FB 28 SOIC – DW
MC68HC05E16	16K	352	320	16-bit: (2IC, 2OC) MFT, RTI	Dual I <sup>2</sup> C	4 ch (8-bit)			47 i/o 2 i	✓	KBI (8 pins) LVI 32 kHz Programmable PLL Periodic Interrupt (.25, .5, 1s)	44 QFP – FB 64 QFP – FU 56 SDIP – B
MC68HC05F5	5K	224		MFT, RTI					30 i/o 1 i	✓	DTMF Receiver Mask IRQ	40 DIP – P 44 PLCC – FN
MC68HC05F6	4K	320		16-bit: (1IC, 1OC)	SPI				26 i/o 4 i 2 o	✓	DTMF Generator 8 High Current Pins (10 mA sink) KBI (6 pins)	42 SDIP – B 44 QFP – FB

**Table 1. 68HC05 Microcontrollers (continued)**

Motorola Part Number	ROM (Bytes)	RAM (Bytes)	EEPROM (Bytes)	Timer	Serial	A/D	PWM	Display Drive	I/O	COP	Comments	Packages
MC68HC05F8	8K	320		16-bit: (11C, 10C) 16-bit: auto	SPI				50 i/o 2 o	✓	DTMF Generator KBI (8 pins) Manchester Encoder/Decoder 8 High Current Pins (10 mA sink)	64 QFP – FU
MC68HC05G1	8K	176		16-bit: (11C, 10C) RTC	SPI	4 ch (8-bit)			40 i/o 8 i	✓	32 kHz PLL – Standby modes	56 SDIP – B 64 QFP – FU
MC68HC05G3	24K	768		16-bit: (11C, 10C) 8-bit: Event Cntr	Dual SPI	8 ch (8-bit)	4 ch (8-bit)		48 i/o 16 i 4 o	✓	KBI (8 pins) Dual Oscillators – Selectable Clock Dual IRQ	80 QFP – FU
MC68HC05J1A	1.2K	64		MFT, RTI					14 i/o	✓	KBI (4 pins) 4 High Current Pins (8 mA sink) Mask Option Pulldowns (14 pins) High Speed Version (HSC05J1A) Low Power Version (HCL05J1A): (1.8 V minimum)	20 DIP – P 20 SOIC – DW
MC68HC05J3	2K	128		16-bit: (11C, 10C) MFT, RTI					14 i/o	✓	14 High Current Pins (8 mA sink) KBI (4 pins)	20 DIP – P 20 SOIC – DW
MC68HC05K0	0.5K	32		MFT, RTI					10 i/o	✓	4 High Current Pins (8 mA sink) Programmable Pulldowns (10 pins) Low Voltage Reset Mask Option Low power version (HCL05K0): (1.8 V minimum)	16 DIP – P 16 SOIC – DW
MC68HC05K1	0.5K	32		MFT, RTI					10 i/o	✓	4 High Current Pins (8 mA sink) PEP (64 bits) Programmable Pulldowns (10 pins) Low Voltage Reset Mask Option	16 DIP – P 16 SOIC – DW
MC68HC05K3	920	64	16 PEEP	MFT, RTI					10 i/o	✓	KBI (4 pins), Programmable Pulldowns (10 pins) 4 High Current Pins (8 mA sink) On-Chip Charge Pump 1.8 V Operating Voltage	16 DIP – P 16 SOIC – DW
MC68HC05L1	4K	128		16-bit: (21C, 20C)		6 ch (8-bit)		64 Segment LCD: (3/4 x 12/16)	17 i/o 15 i 2 o			56 SDIP – B 64 QFP – FU
MC68HC05L5	8K	256		16-bit: (11C, 10C) RTI 8-bit: (11C, 10C)	SIOP			156 Segment LCD: (1–4 x 27–39)	14 i/o 10 i 15 o	✓	KBI (8 pins), Dual Oscillators 8 High Current Pins (10 mA sink) Programmable Pullups (24 pins), Open Drain (31 pins), 2.2 V	80 QFP – FU
MC68HC05L16	16K	512		16-bit: (11C, 10C) RTI 8-bit: (11C, 10C)	SIOP			156 Segment LCD: (1–4 x 27–39)	16 i/o 8 i 15 o	✓	KBI (8 pins), Dual Oscillators 8 High Current Pins (10 mA sink) Programmable Pullups (24 pins) Open Drain (31 pins), 2.2 V Operation	80 QFP – FU
MC68HC05P1A	2K	128		16-bit: (11C, 10C)					20 i/o 1 i	✓	KBI (8 pins) Mask Option Pullups (8 pins) 2 High Current Pins (20 mA)	28 DIP – P 28 SOIC – DW
MC68HC05P3	3K	128	128	16-bit: (11C, 10C) MFT, RTI					22 i/o	✓	KBI (6 pins) On-Chip Charge Pump	28 DIP – P 28 SOIC – DW
MC68HC05P4	4K	176		16-bit: (11C, 10C)	SIOP				20 i/o 1 i	✓	High Speed Option (68HSC05P4) Low Power Option (68HCL05P4): (1.8 V minimum)	28 DIP – P 28 SOIC – DW
MC68HC05P6	4.5K	176		16-bit: (11C, 10C)	SIOP	4 ch (8-bit)			20 i/o 1 i	✓		28 DIP – P 28 SOIC – DW
MC68HC05P7	2K	128		16-bit: (11C, 10C)	SIOP				20 i/o 1 i	✓		28 DIP – P 28 SOIC – DW
MC68HC05P8	2K	112	32	MFT, RTI		4 ch (8-bit)			16 i/o 4 i	✓	LVPI Option on EEPROM On-Chip Charge Pump	28 DIP – P 28 SOIC – DW
MC68HC05P9	2K	128		16-bit: (11C, 10C)	SIOP	4 ch (8-bit)			20 i/o 1 i	✓		28 DIP – P 28 SOIC – DW
XC68HC05P18	8K	192	128	16-bit: (11C, 10C)	SIOP	4 ch (8-bit)			20 i/o	✓	2 High Current Pin KBI (8 pins) Mask Option Pullups (8 pins) LVR, Mask option clock out	28 DIP – P 28 SOIC – DW

**Table 1. 68HC05 Microcontrollers (continued)**

Motorola Part Number	ROM (Bytes)	RAM (Bytes)	EEPROM (Bytes)	Timer	Serial	A/D	PWM	Display Drive	I/O	COP	Comments	Packages
MC68HC05PE0	2K	128		16-bit: (1IC, 1OC)					20 i/o	✓	1 High Current Pin (20 mA sink) PEP (64 bits), KBI (8 pins) Mask Option Pulldowns (8 pins) RC Oscillator Option	28 DIP – P 28 SOIC – DW
XC68HC05RC16	16K	350		Infrared Timer					12 i/o	✓	Mask Option Pullups (12 pins) KBI (12 pins), Low Power Stop Pin	28 DIP – P 28 SOIC – DW
MC68HC05SC11	6K	128							5 i/o		Security Features, 8K EPROM Smartcard Applications, 5 V Only	Die 16 DIP – P 20 SOIC – DW
MC68HC05SC21	6K	128	3K						5 i/o		Security Features On-Chip Charge Pump Smartcard Applications	Die 16 DIP – P 20 SOIC – DW
MC68HC05SC24	3K	128	1K						5 i/o		Security Features On-Chip Charge Pump Smartcard Applications	Die 16 DIP – P 20 SOIC – DW
MC68HC05SC26	6K	224	1024						5 i/o	✓	Smartcard Security Features On-Chip Charge Pump High Speed Option	Die 44 PLCC – FN
MC68HC05SC27	16K	240	3K						5 i/o	✓	Security Features On-Chip Charge Pump Smartcard Applications High Speed Option	Die 16 DIP – P 20 SOIC – DW
XC68HC05SC28	12K	256	8K						5 i/o	✓	Security Features, On-Chip Charge Pump Smartcard Applications High Speed Option	Die 44 PLCC – FN
MC68HC05T1	8K	320		16-bit: (1IC, 1OC)	SIOP	1 ch (6-bit)	9 ch (6-bit)	OSD (64 Char ROM)	29 i/o 1 i	✓	Open Drain PWM Outputs 5 V Only	40 DIP – P 42 SDIP – B
XC68HC05T2	15K	320		16-bit: (1IC, 1OC)	SIOP	1 ch (6-bit)	9 ch (6-bit)	OSD (64 Char ROM)	29 i/o 1 i	✓	Open Drain PWM Outputs 5 V Only	40 DIP – P 42 SDIP – B
MC68HC05T10	12K	320		16-bit: (1IC, 1OC) RTC	I <sup>2</sup> C	1 ch (8-bit)	8 ch (6-bit) 1 ch (14-bit)	OSD (64 Char ROM)	20 i/o 4 i		Open Drain PWM Outputs KBI (8 pins) 5 V Only	56 SDIP – B
MC68HC05T16	24K	320		16-bit: (1IC, 2OC) 8-bit PAC	I <sup>2</sup> C	2 ch (5-bit)	9 ch (7-bit) 1 ch (14-bit)	OSD (128 Char EPROM)	40 i/o	✓	12 V Open Drain I/O lines (up to 22) 4 row OSD buffer Timer output compare functions do not have output pins	56 SDIP – B
MC68HC05X1	12K	336		16-bit: (1IC, 2OC) MFT, RTI	SSI				24 i/o	✓	KBI (8 pins) SAE J1850 Serial Mux Interface 5 V Operation Only	44 PLCC – FN
MC68HC05X4	4K	176		16-bit: (1IC, 1OC) MFT, RTI					16 i/o	✓	CAN (Controller Area Network) KBI (16 pins)	28 SOIC – DW
MC68HC05X16	15K	352	255	16-bit: (2IC, 2OC)	SCI+	8 ch (8-bit)	2 ch (8-bit)		32 i/o	✓	CAN (Controller Area Network) KBI (8 pins) EEPROM Write Protect On-Chip Charge Pump	64 QFP – FU
MC68HC05X32	32K	528	255	16-bit: (2IC, 2OC)	SCI+	8 ch (8-bit)	2 ch (8-bit)		32 i/o	✓	CAN (Controller Area Network) KBI (8 pins) EEPROM Write Protect On-Chip Charge Pump	64 QFP – FU

# ONE-TIME PROGRAMMABLE (OTP) / EMULATOR MCUs

All 68HC705 products have a standard operating voltage range from 3 V to 5.5 V unless noted in Comments.

All 68HC705 products have a standard operating temperature range from 0 – 70°C.

Contact a Motorola Sales Office for availability of extended temperature versions.

**Table 2. One-Time Programmable (OTP)/Emulator MCUs**

Motorola Part Number	EPROM (Bytes)	RAM (Bytes)	EEPROM (Bytes)	Timer	Serial	A/D	PWM	Display Drive	I/O	COP	Comments	Packages
MC68HC705B5	6K	176		16-bit: (2IC, 2OC)	SCI+	8 ch (8-bit)	2 ch (8-bit)		24 i/o 8 i 2 o	✓	Programmable Pulldowns (16 pins) EPROM Write Protect	56 SDIP – B 52 PLCC – FN
MC68HC705B16	15K	352	255	16-bit: (2IC, 2OC)	SCI+	8 ch (8-bit)	2 ch (8-bit)		32 i/o 2 o	✓	On-Chip Charge Pump EEPROM Write Protect	52 PLCC – FN *52 Cerquad – FS 64 QFP – FU
XC68HC705B32	32K	528	255	16-bit: (2IC, 2OC)	SCI+	8 ch (8-bit)	2 ch (8-bit)		32 i/o	✓	On-Chip Charge Pump EEPROM Write Protect	52 PLCC – FN 56 SDIP – B 64 QFP – FU
MC68HC705B03	7.75K	256		MFT, RTI	I <sup>2</sup> C		16 ch (8-bit)		24 i/o	✓	Horizontal and Vertical Sync Signal Processor	42 SDIP – B *42 Cersdip – K 40 DIP – P *40 Cerdip – S
MC68HC705C4A	4K	176		16-bit: (11C, 1OC)	SPI SCI				24 i/o 7 i	✓	Mask Option Register Pullups (8 pins) KBI (8 pins) 1 High Current Pin (20 mA sink) EPROM Security	40 DIP – P 44 PLCC – FN 42 SDIP – B 44 QFP – FB
MC68HC705C8A	8K	304		16-bit: (11C, 1OC)	SPI SCI				24 i/o 7 i	✓	Mask Option Pullups (8 pins) KBI (8 pins) 1 High Current Pin (20 mA sink) High Speed Option (HSC705C8A) Superset of ROM C8A with more RAM EPROM Security	40 DIP – P 44 PLCC – FN *40 Cerdip – S 42 SDIP – B 44 QFP – FB *44 Cerquad – FS
MC68HC705C9A	16K	352		16-bit: (11C, 1OC)	SPI SCI				31 i/o	✓	Mask Option Pullups (8 pins) KBI (8 pins) 1 High Current Pin (20 mA sink) EPROM Security	40 DIP – P *40 Cerdip – S *44 Cerquad – FS 44 PLCC – FN 42 SDIP – B 44 QFP – FB
MC68HC705CJ4	4K	224		16-bit: (11C, 1OC) MFT	SPI SCI I <sup>2</sup> C				29 i/o 3 i	✓	8 High Current Pins (10 mA sink) I <sup>2</sup> C (Slave Only)	44 QFP – FB
XC68HC705D9	16K	352		16-bit: (11C, 1OC)	SCI		5 ch (6-bit)		31 i/o	✓	8 High Current Pins (25 mA sink) 30 kHz PWM	40 DIP – P *44 Cerquad – FS 44 PLCC – FN
MC68HC705E1	4K	368		MFT, RTC RTI					20 i/o	✓	32 kHz PLL Clock Synthesizer	*28 Cerdip – S 28 DIP – P 28 SOIC – DW
XC68HC705F6	4K	320		16-bit: (11C, 1OC)	SPI				26 i/o 4 i		DTMF Generator 8 High Current Pins (10 mA sink) KBI (6 pins)	42 SDIP – B *42 Cersdip – K 64 QFP – FU *64 CQFP – FZ
MC68HC705F8	8K	320		16-bit: (11C, 1OC) 16-bit: auto	SPI				50 i/o 2 o	✓	DTMF Generator KBI (8 pins) 8 High Current Pins (10 mA sink) Manchester Encoder/Decoder	64 QFP – FU *64 CQFP – FZ
MC68HC705G1	12K	176		16-bit: (11C, 1OC) RTC	SPI	4 ch (8-bit)			40 i/o 8 i	✓	32 kHz PLL	56 SDIP – B *56 Cersdip – K 64 QFP – FU *64 CQFP – FZ
MC68HC705G4	32K	1024		16-bit: (11C, 1OC) 8-bit: Event Cntr	Dual SPI	8 ch (8-bit)	4 ch (8-bit)		48 i/o 16 i 4 o	✓	KBI (8 pins) Dual IRQ Dual Oscillators, Selectable Clock	80 QFP – FU *80 CQFP – FZ
MC68HC705J1A	1.2K	64		MFT, RTI					14 i/o	✓	KBI (4 pins), EPROM Security Feature 4 High Current Pins (8 mA sink) Mask Option Pulldowns (14 pins)	20 DIP – P 20 SOIC – DW *20 Cerdip – S
MC68HC705J2	2K	112		MFT, RTI					14 i/o	✓		20 DIP – P 20 SOIC – DW *20 Cerdip – S
MC68HC705K1	0.5K	32		MFT, RTI					10 i/o	✓	4 High Current Pins (8 mA sink) PEP (64 bits) Programmable Pulldowns (10 pins) Low Voltage Reset Mask Option	16 DIP – P 16 SOIC – DW *16 Cerdip – S

**Table 2. One-Time Programmable (OTP)/Emulator MCUs (continued)**

Motorola Part Number	EPROM (Bytes)	RAM (Bytes)	EEPROM (Bytes)	Timer	Serial	A/D	PWM	Display Drive	I/O	COP	Comments	Packages
XC68HC705L1	6K	128		16-bit: (2IC, 2OC)		6 ch (8-bit)		64 Segment LCD: (3/4 x 12/16)	17 i/o 15 i 2 o			56 SDIP – B 64 QFP – FU *64 CQFP – FZ *56 Cerdip – K
MC68HC705L5	8K	256		16-bit: (11C, 1OC) RTI 8-bit: (11C, 1OC)	SIOP			156 Segment LCD: (1–4 x 27–39)	14 i/o 10 i 15 o		KBI (8 pins), Dual Oscillators 8 High Current Pins (10 mA sink) Programmable Pullups (24 pins) Open Drain (31 pins)	80 QFP – FU *80 CQFP – FZ
MC68HC705L16	16K	512		16-bit: (11C, 1OC) RTI 8-bit: (11C, 1OC)	SIOP			156 Segment LCD: (1–4 x 27–39)	16 i/o 8 i 15 o	✓	KBI (8 pins), Dual Oscillators 8 High Current Pins (10 mA sink) Programmable Pullups (24 pins) Open Drain (31 pins)	80 QFP – FU *80 CQFP – FZ
MC68HC705P6	4.5K	176		16-bit: (11C, 1OC)	SIOP	4 ch (8-bit)			20 i/o 1 i	✓		28 DIP – P 28 SOIC – DW *28 Cerdip – S
MC68HC705P9	2K	128		16-bit: (11C, 1OC)	SIOP	4 ch (8-bit)			20 i/o 1 i	✓		28 DIP – P 28 SOIC – DW *28 Cerdip – S
MC68HC705SR3	3.75K	192		8-bit Timer (7-bit prescaler)		4 ch (8-bit)			32 i/o		Programmable Pullups (24 pins) KBI (8 pins), LED drive (8 pins) LVR	40 DIP – P *40 Cerdip – S 42 SDIP – B 44 QFP – FB
MC68HC705T10	12K	320		16-bit: (11C, 1OC) RTC	I <sup>2</sup> C	1 ch (8-bit)	8 ch (6-bit) 1 ch (14-bit)	OSD (64 Char EPROM)	20 i/o 4 i		Open Drain PWM Outputs KBI (8 pins) 5 V Only	56 SDIP – B *56 Cerdip – K
MC68HC705T16	24K	320		16-bit: (11C, 2OC) 8-bit PAC	I <sup>2</sup> C	2 ch (5-bit)	9 ch (7-bit) 1 ch (14-bit)	OSD (128 Char EPROM)	40 i/o	✓	12 V Open Drain I/O Lines (Up to 22) 4 Row OSD Buffer Timer output compare functions do not have output pins	56 SDIP – B *56 Cerdip – K
XC68HC705V8	12K	512	128	16-bit: (11C, 1OC) MFT, RTI	SPI	8 ch (8-bit)	1 ch (6-bit)		22 i/o	✓	LVR, On Chip Charge Pump, MDLC (Message Datalink Control) 5 V Regulator, KBI (16 pins)	56 SDIP – B 68 PLCC – FN 68 CLCC – FS 56 Cerdip – K
XC68HC705X4	4K	176		16-bit: (11C, 1OC) MFT, RTI					16 i/o	✓	CAN (Controller Area Network) KBI (16 pins)	28 SOIC – DW

\*Windowed packages available only in sample quantities.

**Definitions**

- CAN – Controller Area Network
- CCTV – Closed Caption Television
- COP – Computer Operating Properly (Watch Dog Timer)
- DTMF – Dual-Tone Multi-Frequency
- EBI – External Bus Interface
- IC – Input Capture
- I<sup>2</sup>C – Inter-Integrated Circuit
- IDE – Integrated Device Electronics (IBM PC/AT Type)
- i/o – Bidirectional Input and Output Port Pins
- i – Input Only Port Pins
- KBI – Key Board Interrupt
- LCD – Liquid Crystal Display
- LVI – Low Voltage Interrupt
- LVPI – Low Voltage Program Inhibit
- LVR – Low Voltage Reset
- MDLC – Message Data Link Controller (J1850)
- MFT – Multi Function Timer
- o – Output Only Port Pins

- OC – Output Compare
- OSD – On-Screen Display
- PEEP – Personality EPROM
- PEP – Personality EPROM
- PIO – Parallel Input Output (IBM PC/AT Type)
- PLL – Phase-Lock Loop
- PWM – Pulse-Width Modulation
- RTC – Real-Time Clock
- RTI – Real-Time Interrupt
- SCI – Serial Communications Interface (asynchronous)
- SCI+ – Serial Communications Interface (asynch. and sync.)
- SIO – Serial Input Output (IBM PC/AT Type)
- SIOP – Simple Serial I/O Port
- SPI – Serial Peripheral Interface
- VFD – Vacuum Fluorescent Display
- VREG – Voltage Regulator
- WDOG – Watch Dog Timer

**Package Definitions**

- B – Shrink DIP (70 mil spacing)
- DW – Small Outline (Wide-Body) SOIC
- FA – 7 x 7 mm Quad Flat Pack (QFP)
- FB – 10 x 10 mm Quad Flat Pack (QFP)
- FE – CQFP (windowed) – Samples Only
- FN – Plastic Quad (PLCC)
- FS – CLCC (windowed) – Samples Only
- FT – 28 x 28 mm Quad Flat Pack (QFP)
- FU – 14 x 14 mm Quad Flat Pack (QFP)
- FZ – CQFP (windowed) – Samples Only
- K – Cerdip (windowed) – Samples Only
- L – Ceramic Sidebrazed
- P – Dual-in-Line Plastic
- S – Cerdip (windowed) – Samples Only

# MCU NEW PRODUCTS

All 68HC05 and 68HC705 products have a standard operating voltage range from 3 V to 5.5 V unless noted in Comments.

All 68HC05 and 68HC705 products have a standard operating temperature range from 0 to 70°C.

Contact a Motorola Sales Office for availability of the following MCUs:

**Table 3. MCU New Products**

Motorola Part Number	ROM/ EPROM (Bytes)	RAM (Bytes)	EEPROM (Bytes)	Timer	Serial	A/D	PWM	Display Drive	I/O	COP	Comments	Packages
68HC05B32	32K	528	256	16-bit: (2IC, 2OC)	SCI+	8 ch (8-bit)	2 ch (8-bit)		32 i/o	✓	On-Chip Charge Pump EEPROM Write Protect	52 PLCC – FN 56 SDIP – B 64 QFP – FU
68HC05C0	0	512		16-bit: (1IC, 1OC) MFT	SCI+				18 i/o	✓	Mux or Non-Mux EBI (16-bit) 3 Chip Selects, KBI (8 pins) Programmable Pullups (8 pins) 1 High Current Pin (20 mA sink)	40 DIP – P *40 Cerdip – S 44 PLCC – FN *44 Cerquad – FS
68HC705D32A	32K	352		16-bit: (1IC, 1OC)	SCI		5 ch (6-bit)		31 i/o	✓	8 High Current Pins (24 mA sink) 30 kHz PWM, KBI (8 pins)	40 DIP – P *40 Cerdip – S 44 PLCC – FN *44 Cerquad – FS
68HC705E5	5K	384		MFT, RTI	I <sup>2</sup> C				20 i/o	✓	32 kHz PLL Clock Synthesizer	28 DIP – P *28 Cerdip – S 28 SOIC – DW
68HC705JP7	6K + 64-bit PEP	224		16-bit: (1IC, 1OC) MFT, RTI	SIOP	See Comments			14 i/o	✓	Two voltage comparators used with timer to create 4 channel A/D, KBI (4 pins), Programmable Pulldowns (14 pins), 6 Hi Current Pins (10 mA sink), EPROM security feature, LVI	20 DIP – P 20 SOIC – DW
68HC805K3		64	920 16PEEP	MFT, RTI					10 i/o	✓	KBI (4 pins), Programmable Pulldowns (10 pins), 4 High Current Pins (8 mA sink), On-Chip Charge Pump, 1.8 V EE Read	16 DIP – P 16 SOIC – DW
68HC705MC4	3.5K	176		16-bit: (2IC or 1IC, 1OC) MFT, RTI	SCI	6 ch (8-bit)	2 hi sp (8-bit 24 kHz Max)		22 i/o	✓	One 8-bit High Current Port (10 mA Source Pin, 20 mA Max/Port) Low EMI Pinout 1 High Sink Current Pin (10 mA) Commutation Mux for PWM	28 DIP – P *28 Cerdip – S 28 SOIC – DW
68HC05MC4	3.5K	176		16-bit: (2IC or 1IC, 1OC) MFT, RTI	SCI	6 ch (8-bit)	2 hi sp (8-bit 24 kHz Max)		22 i/o	✓	One 8 bit High Current Port (10 mA Source Pin, 20 mA Max/Port) Low EMI Pinout 1 High Sink Current Pin (10 mA) Commutation Mux for PWM	28 DIP – P 28 SOIC – DW
68HC705P6A	4K	176		16-bit: (1IC, 1OC)	SIOP	4 ch (8-bit)			20 i/o	✓	KBI (8 pins) 2 High Current Pins (15 mA sink)	28 DIP – P 28 SOIC – DW
68HC05P9A	2K	128		16-bit: (1IC, 1OC)	SIOP	4 ch (8-bit)			20 i/o	✓	KBI (8 pins) 2 High Current Pins (15 mA sink)	28 DIP – P 28 SOIC – DW
68HC05P18		192	8K + 128	16-bit: (1IC, 1OC)	SIOP	4 ch (8-bit)			20 i/o	✓	KBI (8 pins), LVR 2 High Current Pins Pullups (8 pins), clock out option	28 DIP – P 28 SOIC – DW
68HC705RC16	16K	350		Infrared Timer					12 i/o	✓	Mask Option Pullups (12 pins) KBI (12 pins)	28 DIP – P *28 Cerdip – S 28 SOIC – DW
68HC705RC17	16K	350		Infrared Timer					12 i/o	✓	Mask Option Pullups (12 pins) KBI (12 pins) Phase-Locked Loop (PLL)	28 DIP – P *28 Cerdip – S 28 SOIC – DW
68HC05RC17	16K	350		Infrared Timer					12 i/o	✓	Mask Option Pullups (12 pins) KBI (12 pins) Phase-Locked Loop (PLL)	28 DIP – P 28 SOIC – DW
68HC05SR3	3.75K	192		8-bit Timer (7-bit prescaler)		4 ch (8-bit)			32 i/o		Mask Option Pullups (24 pins) KBI (8 pins), LED Drive (8 pins), LVR	40 DIP – P 42 SDIP – B 44 QFP – FB
68HC05V7	10K	384	128	16-bit: (1IC, 1OC) MFT, RTI	SPI	8 ch (8-bit)	1 ch (6-bit)		22 i/o 16 i	✓	MDLC (Message Datalink Control) 5 V Power Regulator KBI (16 pins) LVR	56 SDIP – B 68 PLCC – FN
68HC705X32	32K	528	255	16-bit: (2IC, 2OC)	SCI+	8 ch (8-bit)	2 ch (8-bit)		32 i/o	✓	CAN (Controller Area Network)	64 QFP – FU
68HC08XL36	36K	1K		4 ch 16-bit: (IC, OC, or PWM)	SCI SPI				43 i/o	✓	8 MHz Internal Bus (5 V) Direct Memory Access Module (3 ch) Programmable PLL, LVI/LVR KBI (8 pins), Programmable Pullups (8 pins)	56 SDIP – B 64 QFP – FU

**Table 3. MCU New Products**

Motorola Part Number	ROM/ EPROM (Bytes)	RAM (Bytes)	EEPROM (Bytes)	Timer	Serial	A/D	PWM	Display Drive	I/O	COP	Comments	Packages
68HC708XL36	36K	1K		4 ch 16-bit: (IC, OC, or PWM)	SCI SPI				43 I/O	✓	8 MHz Internal Bus (5 V) Direct Memory Access Module (3 ch) Programmable PLL, LV/LVR KBI (8 pins), Programmable Pullups (8 pins)	*56 SDIP – B *56 Cerdip – K 64 QFP – FU *64 CQFP – FE



# M68HC08 Family

The M68HC08 Family offers a unique combination of high-speed, low-power, enhanced processing performance for cost-sensitive 8-bit applications. Full upward object code compatibility with the world's leading 8-bit microcontroller allows current M68HC05 users to leverage their resource and time investment. M68HC08 modular design utilizes a growing library of on-chip peripherals. The flagship 68HC(7)08X36 OTP and ROM versions for general purpose use are the first two devices in the family.

## Features

- Architecturally Enhanced 8-Bit CPU
  - 8 MHz bus speed yields 125 ns minimum instruction cycle
  - 16-bit stack with stack pointer operations and addressing modes
  - 16-bit index register
  - 78 new instructions including advanced looping control
  - Eight new addressing modes
- Fully upward object code compatible with the M68HC05 and M6805 families
- Direct Memory Access Module
  - Memory-to-memory transfer
  - Peripheral-to-memory and memory-to-peripheral transfer
- Timing Interface Module
  - Four independently programmable channels
  - Input capture, output compare, buffered, and unbuffered PWM configurations
- Interface Modules
  - Serial Communications Interface (UART)
  - Serial Peripheral Interface
  - System Interface Module
- System Control Modules
  - Low Voltage Inhibit, PLL, COP, and System Integration Module
- Clock Generator Module
  - Generates two different clock signals from a user-selected source

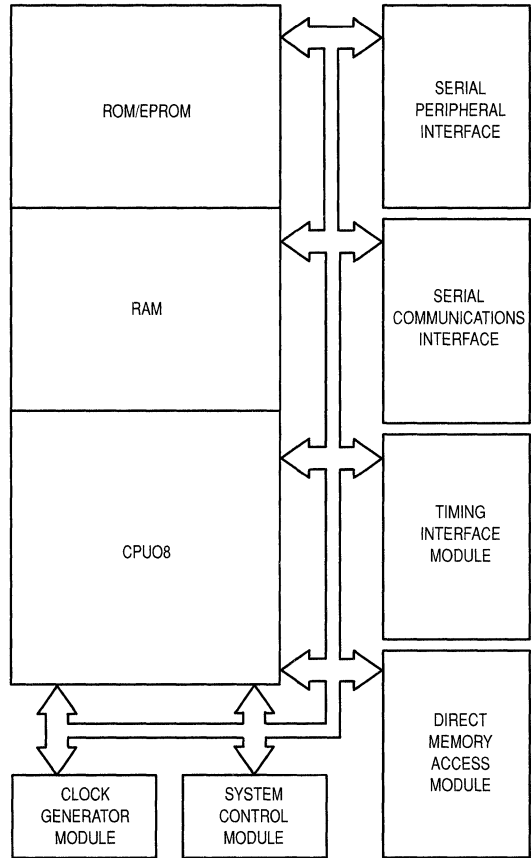


Figure 3. Block Diagram of Typical M68HC08 MCU

# M68HC05 Microcontroller Development Tools

Motorola now offers two fully modular development system choices: the new Motorola Modular Evaluation System (MMEVS) and our popular, high-performance Motorola Modular Development System (MMDS). You can now build a customized MMEVS or MMDS to emulate the MCU in your target design in four simple steps. First, order the MMEVS or MMDS system platform (M68MMPFB0508 or M68MMDS05). Second, select and order the emulation module (EM) that contains circuitry specific to emulating the particular HC05/08 MCU in your target application. Third, complete the system by ordering target cable accessories to connect the MMEVS or MMDS to your target MCU socket. Finally, select the appropriate parallel programmer to program your prototype devices.

## Choosing Between the MMEVS and MMDS

Build an economical MMEVS system to perform traditional debugging activities such as executing code in run or step mode; setting breakpoints; monitoring or modifying CPU registers, memory and application variables; and creating log or script files to record test results or automate the testing

process. Or, create an MMDS system to add high-performance, advanced emulation features such as real-time, dual-ported memory and a real-time bus state analyzer with an 8K trace buffer. In addition, the MMDS includes a built-in power supply and is fully enclosed in a metal case. Both the MMEVS and MMDS include a host-based Integrated Development Environment (IDE) comprised of an editor, assembler, and hardware debugger.

## Modular Architecture Benefits

The MMEVS replaces Motorola's older-style EVS and EVM development tool products. A proper subset of the MMDS architecture, the new MMEVS is fully compatible with all EM products supported by the MMDS. The MMEVS extends the emulation performance beyond that of the EVS and EVM by supporting full, real-time, non-intrusive, in-circuit emulation for the new high-speed devices (68HSC05) in the HC05 Family and the new HC08 architecture. The MMEVS also extends emulation support to all low-voltage HC05/HC08 derivatives. The common hardware, firmware, and software design of the MMEVS and MMDS also provide greater flexibility in mixing and matching Motorola hardware tools with the ever-increasing variety of C compilers, assemblers, and integrated development environment product offerings from Motorola's third party developer companies.

## CONFIGURATION AND ORDER INFORMATION FOR MMDS/MMEVS

Table 4. Configuration and Order Information for MMDS/MMEVS

Devices	Platform	Emulation Modules	Package Type	In-Circuit Target Cable		
				Low Noise Flexcable	Target Head Adapter	Surface Mount Adapter
68HC05A16 68HC705A24	M68MMPFB0508_QR M68MMDS05	M68EM05A24	56 SDIP – B	M68CBL05B	M68TB05A24B56	
68HC05B4/B6/B8/B16/B32 68HC705B5/B16/B32	M68MMPFB0508_QR M68MMDS05	M68EM05B32	56 SDIP – B	M68CBL05B	M68TB05B32B56	
			64 QFP – FU	M68CBL05C	M68TC05B32FU64	M68TQS064SAG1+ M68TQP064SA1+
			52 PLCC – FN	M68CBL05C	M68TC05B32FN52	
68HC05BD3/BD5 68HC705BD3/BD5	M68MMPFB0508_QR M68MMDS05	M68EM05BD3	40 DIP – P	M68CBL05B	M68TB05BD3P40	
			42 SDIP – B	M68CBL05B	M68TB05BD3B42	
68HC05BS8 68HC705BS8	M68MMPFB0508_QR M68MMDS05	M68EM05BS8	44 QFP – FB	M68CBL05C	M68TC05BS8FB44	M68TQS044SAG1+ M68TQP044SAMO1+
			52 PLCC – FN	M68CBL05B	M68TB05BS8FN52	
68HC05C0	M68MMPFB0508_QR M68MMDS05	M68EM05C0	40 DIP – P	M68CBL05B	M68TB05C0P40	
			42 SDIP – B	M68CBL05B	M68TB05C0B42	
			44 PLCC – FN	M68CBL05	M68TC05C0FN44	
			44 QFP – FB	M68CBL05C	M68TC05C0FB44	M68TQS044SAG1+ M68TQP044SAMO1+
68HC05C5 68HC705C5	Refer to the Configuration and Order Information for Other Motorola Development Tools Section to select a development tool for the 68HC05C5/68HC705C5.					
68HC05C4/C4A/C8A/C12A 68HC705C4A/705C8A	M68MMPFB0508_QR M68MMDS05	M68EM05C9	40 DIP – P	M68CBL05B	M68TB05C9P40	
			44 PLCC – FN	M68CBL05C	M68TC05C4FN44	
			44 QFP – FB	M68CBL05C	M68TC05C9FB44	M68TQS044SAG1+ M68TQP044SAMO1+
			42 SDIP – B	M68CBL05B	M68TB05C9B42	

**Table 4. Configuration and Order Information for MMDS/MMEVS (continued)**

Devices	Platform	Emulation Modules	Package Type	In-Circuit Target Cable		
				Low Noise Flexcable	Target Head Adapter	Surface Mount Adapter
68HC05C9/C9A 68HC705C9/705C9A	M68MMPFB0508_QR M68MMDS05	M68EM05C9	40 DIP – P	M68CBL05B	M68TB05C9P40	
			44 PLCC – FN	M68CBL05C	M68TC05C9FN44	
			42 SDIP – B	M68CBL05B	M68TB05C9B42	
			44 QFP – FB	M68CBL05C	M68TC05C9FB44	M68TQS044SAG1+ M68TQP044SAMO1+
68HC05CCV 68HC705CCV	Refer to the Configuration and Order Information for Other Motorola Development Tools Section to select a development tool for the 68HC05CCV/68HC705CCV.					
68HC05CJ4 68HC705CJ4	M68MMPFB0508_QR M68MMDS05	M68EM05CJ4	44 QFP – FB	M68CBL05C	M68TC05CJ4FB44	M68TQS044SAG1+ M68TQP044SAMO1+
			44 PLCC – FN	M68CBL05C	M68TC05C9FN44	
			44 QFP – FB	M68CBL05C	M68TC05C9FB44	M68TQS044SAG1+ M68TQP044SAMO1+
68HC05D9/D24/D32 68HC705D9/D32A	M68MMPFB0508_QR M68MMDS05	M68HC05D32EM	40 DIP – P	M68CBL05B	M68TB05C9P40	
			44 QFP – FB	M68CBL05C	M68TC05C9FB44	M68TQS044SAG1+ M68TQP044SAMO1+
68HC05E6 68HC705E6	M68MMPFB0508_QR M68MMDS05	M68EM05E6	28 SOIC – DW	M68CBL05C	M68TC05E6P28	M68DIP28SOIC
			44 QFP – FB	M68CBL05C	M68TC05E6FB44	M68TQS044SAG1+ M68TQP044SAMO1+
68HC05F4 68HC705F4	M68MMPFB0508_QR M68MMDS05	M68EM05F4	28 DIP – P	M68CBL05C	M68TC05E6P28	
			28 SOIC – DW	M68CBL05C	M68TC05E6P28	M68DIP28SOIC
			44 QFP – FB	M68CBL05C	M68TC05E6FB44	M68TQS044SAG1+ M68TQP044SAMO1+
68HC05F6 68HC705F6	M68MMPFB0508_QR M68MMDS05	M68EM05F6	42 SDIP – B	M68CBL05B	M68TB05F6B42	
			44 QFP – FB	M68CBL05C	M68TC05F6FB44	M68TQS044SAG1+ M68TQP044SAMO1+
			64 QFP – FU	M68CBL05C	M68TC05F6FU64	M68TQS064SAG1+ M68TQP064SAMO1+
68HC05F8 68HC705F8	Refer to the Configuration and Order Information for Other Motorola Development Tools Section to select a development tool for the 68HC05F8/68HC705F8.					
68HC05G1 68HC705G1	M68MMPFB0508_QR M68MMDS05	M68EM05G1	56 SDIP – B	M68CBL05B	M68TB05G1B56	
			64 QFP – FU	M68CBL05C	M68TC05G1FU64	M68TQS064SAG1+ M68TQP064SAMO1+
68HC05G3 68HC705G4	M68MMPFB0508_QR M68MMDS05	M68EM05G4	80 QFP – FU	M68CBL05E	M68TE05G4FU80	M68TQS080SBG1+ M68TQP080SBMO1+
68HC05J1 68HC705J2	M68MMPFB0508_QR M68MMDS05	M68HC05JPEM	20 DIP – P	M68CBL05A	M68TA05J2P20	
			20 SOIC – DW	M68CBL05A	M68TA05J2P20	M68DIP20SOIC
68HC05J1A 68HC705J1A	M68MMPFB0508_QR M68MMDS05	M68EM05J1A	20 DIP – P	M68CBL05A	M68TA05J2P20	
			20 SOIC – DW	M68CBL05A	M68TA05J2P20	M68DIP20SOIC
68HC05J3 68HC705J3	M68MMPFB0508_QR M68MMDS05	M68EM05J3	20 DIP – P	M68CBL05A	M68TA05J2P20	M68DIP20SOIC
			20 SOIC – DW	M68CBL05A	M68TA05J2P20	
68HC05K0/K1/K3 68HC705K1	M68MMPFB0508_QR M68MMDS05	M68EM05K3	16 DIP – P	M68CBL05A	M68TA05K1P16	
			16 SOIC – DW	M68CBL05A	M68TA05K1P16	M68DIP16SOIC
68HC05L1 68HC705L1	M68MMPFB0508_QR M68MMDS05	M68EM05L1	56 SDIP – B	M68CBL05B	M68TB05L1B56	M68TQS064SAG1+ M68TQP064SAMO1+
			64 QFP – FU	M68CBL05C	M68TC05L1FU64	
68HC05L2 68HC705L2	M68MMPFB0508_QR M68MMDS05	M68HC05L2EM	42 SDIP – B	42–SDIP ribbon cable assembly included with M68HC05L2EM.		
68HC05L5/L16 68HC705L5/L16	M68MMPFB0508_QR M68MMDS05	M68EML05L16	80 QFP – FU	M68CBL05E	M68TE05L16FU80	M68TQS080SBG1+ M68TQP080SBMO1+
68HC05L7/L9/L11 68HC705L10 68HC05M4	Refer to the Configuration and Order Information for Other Motorola Development Tools Section to select a development tool for the 68HC05L7/L9, 68HC05L10, 68HC05L11, or 68HC05M4.					
68HC05MC4 68HC705MC4	M68MMPFB0508_QR M68MMDS05	M68EM05MC4	28 DIP – P 28 SOIC – DW	M68CBL05A M68CBL05A	M68TA05MC4P28* M68TA05MC4P28*	M68DIP28SOIC

**Table 4. Configuration and Order Information for MMDS/MMEVS (continued)**

Devices	Platform	Emulation Modules	Package Type	In-Circuit Target Cable		
				Low Noise Flexcable	Target Head Adapter	Surface Mount Adapter
68HC05P3	M68MMPFB0508 QR M68MMDS05	M68EM05P3	28 DIP – P	M68CBL05A	M68TA05X4P28	
			28 SOIC – DW	M68CBL05A	M68TA05X4P28	M68DIP28SOIC
68HC05P8	M68MMPFB0508	M68HC05JPEM	28 DIP – P	M68CBL05A	M68TA05P8P28	
			28 SOIC – DW	M68CBL05A	M68TA05P8P28	M68DIP28SOIC
68HC05P1/P4/P6/P7/P9 68HC705P6/705P9	M68MMPFB0508 QR M68MMDS05	M68HC05P9EM (Included with MMDS)	28 DIP – P	M68CBL05A	M68TA05P9P28	
			28 SOIC – DW	M68CBL05A	M68TA05P9P28	M68DIP28SOIC
68HC05P18 68HC805P18	M68MMPFB0508 QR M68MMDS05	M68EM05P18*	28 DIP – P	M68CBL05A	M68TA05P9P28	
			28 SOIC – DW	M68CBL05A	M68TA05P9P28	M68DIP28SOIC
68HC05RC16 68HC705RC16	M68MMPFB0508 QR M68MMDS05	M68EM05RC16	28 DIP – P	M68CBL05A	M68TA05RC16P28	
			28 SOIC – DW	M68CBL05A	M68TA05RC16P28	M68DIP28SOIC
68HC05SC11/SC21/SC24/ SC27		CONTACT SALES OFFICE	die/card	ISO Adapter Included w/EM.		
68HC05SR3 68HC705SR3	M68MMPFB0508 QR M68MMDS05	M68EM05SR3	40 DIP – P	M68CBL05B	M68TB05SR3P40	
			44 QFP – FB	M68CBL05C	M68TC05SR3FB44	M68TQS044SAG1† M68TQP044SAMO1†
			42 SDIP – B	M68CBL05B	M68TB05SR3B42	
68HC05T1/T2	Refer to the Configuration and Order Information for Other Motorola Development Tools Section to select a development tool for the 68HC05T1/T2.					
68HC05T10 68HC705T10	M68MMPFB0508 QR M68MMDS05	M68EM05T7	56 SDIP – B	M68CBL05B	M68TB05T7B56	
68HC05V7 68HC705V8	M68MMPFB0508 QR M68MMDS05	M68EM05V8	56 SDIP – B	M68CBL05B	M68TB05V8B56	
68HC05V12 68HC705V12	M68MMPFB0508 QR M68MMDS05	M68EM05V12*	68 PLCC – FN	M68CBL05C	M68TC05V12FN68*	
68HC05X4 68HC705X4	M68MMPFB0508 QR M68MMDS05	M68EM05X4	28 DIP – P	M68CBL05A	M68TA05X4P28	
			28 SOIC – DW	M68CBL05A	M68TA05X4P28	M68DIP28SOIC
68HC05X16/X32 68HC705X32	M68MMPFB0508 QR M68MMDS05	M68EML05X32	64 QFP – FU	M68CBL05E	M68TE05X32FU64	M68TQS064SAG1† M68TQP064SA1†
68HC08XL36 68HC708XL36	M68MMPFB0508 QR M68MMDS05	M68EML08XL36	64 QFP – FU	M68CBL05C	M68TC08XL36FU6 4*	M68TQS064SAG1† M68TQP064SAMO1†
			56 SDIP – B	M68CBL05B	M68TB08XL36B56*	

\* Development tools that are scheduled for availability during 1Q96.

† To support more than one QFP target system, separate purchase of additional TQPACKs is required. Contact your Motorola representative for details.

Each QFP target head includes one TQSOCKET1 with guides (M68TQS0xxSyG1) and one TQPACK disposable surface mount adapter (M68TQP0xxSy1 (1.2 mm lead length) or M68TQP0xxSyMO1 (1.6 mm lead length)). Order additional TQSOCKETs and TQPACKs using part numbers referenced in the Surface Mount Adapters column to support multiple target systems. Contact your Motorola representative for details.

# CONFIGURATION AND ORDER INFORMATION FOR OTHER MOTOROLA DEVELOPMENT TOOLS (EVM/EVS/ICS)

**Table 5. Configuration and Order Information for Other Motorola Development Tools (EVM/EVS/ICS)**

Devices	Development Tool	Package Type	In-Circuit Target Cable			Comments
			Low Noise Flexcable	Target Head Adapter	Surface Mount Adapter	
68HC05C5 68HC705C5	M68HC05C5EVS	40 DIP – P	Not Available			For DIP package user must supply a ribbon cable assembly to interface to user's target system.
		44 PLCC – P	Not Available			For PLCC package, user has the option to order 44PLCC05M, which is the old-style ribbon cable assembly with PLCC target adapter.
68HC05CCV 68HC705CCV	Order M68HC05CCVEM and M68HC05PFB	42 SDIP – B	M68CBL05B	M68TB05CCVB42		
		44 QFP – FB	M68CBL05C	M68TC05CCVFB44	M68TQS044SAG1† M68TQP044SAMO1†	
68HC05J1A 68HC705J1A	M68HC705JICS	20 DIP – P	20 DIP Ribbon Cable Assembly Included With M68HC705JICS			M68HC705KICS In-Circuit Simulator
		20 SOIC – DW	See Above		M68DIP20SOIC	For the SOIC package, user may order M68DIP20SOIC, which is a 20-pin DIP to SOIC adapter.
68HC05K0/K1 68HC705K1	M68HC705KICS	16 DIP – P	16 DIP Ribbon Cable Assembly Included With M68HC705KICS			M68HC705KICS In-Circuit Simulator
		16 SOIC – DW	See Above		M68DIP16SOIC	For the SOIC package, user may order M68DIP16SOIC, which is a 16 pin DIP to SOIC adapter.
68HC05L7/L9	M68HC05L9EVM2	128 QFP – FT	Not Available			
68HC05L10	M68HC05L10EVM	128 QFP – FT	Not Available			
68HC05L11	M68HC05L11EVM	100 QFP – FU	Not Available			
68HC05M4	M68HC05M4EVM	52 PLCC – FN	Not Available			For PLCC package, user has the option to order 52PLCCU, which is the old-style ribbon cable assembly with PLCC target adapter.
68HC05T1/T2	M68HC05T2EVS	40 DIP – P	Not Available			For DIP/SDIP package, user must supply a ribbon cable assembly to interface to user's target system.
		42 SDIP – B	Not Available			
		44 PLCC – FN	Not Available			For PLCC package, user has the option to order 44PLCC05M, which is the old-style ribbon cable assembly with PLCC target adapter.

# CONFIGURATION AND ORDER INFORMATION FOR PROGRAMMERS

**Table 6. Configuration and Order Information for Programmers**

Devices	Packages Supported	Programmer Boards	Comments
68HC705A24	56 SDIP – B	M68HC05UPGMR	M68HC705UPGMR requires package adapter, M68UPA05A24B56.
68HC705B5/B16/B32	52 PLCC – FN 56 SDIP – B	M68HC05BPGMR	For QFP package, order M68HC705X32PGMR.
68HC705BD3/BD5	40 DIP – P 42 SDIP – B	M68HC705UPGMR	M68HC705UPGMR requires package adapter. For 40 DIP – P, order M68UPA05BD3P40. For 42 SDIP – B, order M68UPA05BD3B42.
68HC705C4A/C5/C8/C8A/C9	40 DIP – P/S 44 PLCC – FN/FS	M68HC05PGMR–2	Order M68ADT05P40FB44 adapter to program 44 QFP – FB.
68HC705D9	40 DIP – P/S 44 PLCC – FN/FS	M68HC05PGMR–2	Order M68ADT05P40FB44 adapter to program 44 QFP – FB.
68HC705E6	44 QFP – FB 28 SOIC – DW	M68HC705E6PGMR	
68HC705F4	28 DIP – P 28 SOIC – DW 44 QFP – FB	M68HC705F4PGMR	
68HC705F6	64 QFP – FU/FZ 42 SDIP – B/K	M68HC705F6PGMR64	
68HC705F8	64 QFP – FU/FZ	M68HC705F8PGMR	
68HC705G1	56 SDIP – B 64 QFP – FU	M68HC705G1PGMR	
68HC705J1A	20 DIP – P	M68HC705JICS	M68HC705JICS In-circuit simulator. SOIC requires user-supplied socket or adapter. (Available from Yamaichi, part number IC51–0282–334–1)
68HC705J2/J3	20 DIP – P/S	M68HC705J2PGMR	SOIC requires user-supplied socket or adapter. (Available from Yamaichi, part number IC51–0282–334–1)
68HC705K1	16 DIP – P/S	M68HC705KICS M68HC705K1GANG	M68HC705K1GANG Programs up to 8 68HC705K1S or P.
	16 SOIC – DW**	M68HC705K1GANGY	M68HC705K1GANGY Programs up to 8 68HC705K1S, P, or DW.
68HC705L1	56 SDIP – B/K 64 QFP – FU/FZ	M68HC705L1PGMR	
68HC705L2	42 SDIP – B	M68HC705L2PGMR	
68HC705L5/L16	80 QFP – FU/FZ	M68HC705L5PGMR	
68HC705MC4	28 DIP – P 28 SOIC – DW	M68HC705MC4PGMR	
68HC705P3	28 DIP – P 28 SOIC – DW	M68HC705E6PGMR	
68HC705P6/P9	28 DIP – P/S	M68HC705P9PGMR	SOIC requires user-supplied socket or adapter.
68HC805P18	28 DIP – P/S	M68HC805P18PGMR*	SOIC requires user-supplied socket or adapter.
68HC705SR3	40 DIP – P 42 SDIP – B 44 QFP – FB	M68HC05SR3PGMRSG	M68HC05SR3PGMRSG requires package adapter. For 40 DIP – P, order M68HC05SR3PAP40. For 42 SDIP – B, order M68HC05SR3PAB42. For 44 QFP – FB, order M68HC05SR3PAFB44.
68HC705T10	56 SDIP – B/K	M68HC705T10PGMR	
68HC705V8	56 SDIP – B 68 PLCC – FN	M68HC705V8PGMR	
68HC705V12	68 PLCC – FN	M68HC705V12PGMR*	
68HC705X4	28 DIP – P/S 28 SOIC – DW	M68HC705X4PGMR	
68HC705X32	64 QFP – FU 68 PLCC – FN	M68HC705X32PGMR	
68HC708XL36	64 QFP – FU 56 SDIP – B/K	M68SPGMR08*	

\*Development tools that are scheduled for availability during 1Q96.

\*\*SOIC on M68HC705K1GANGY only.

# THIRD PARTY DEVELOPERS FOR 68HC05 AND 68HC705 FAMILY MCUs

**Table 7. Third Party Developers for 68HC05 and 68HC705 Family MCUs**

Programmers			
Advin Systems Inc.	USA	(408) 243-7000 (800) 627-2456	
	Canada:		
	Eastern	(514) 337-0723	
	Western	(604) 986-1286	
	France	+33 13961-1414	
	Germany	+49 7459-1271	
	UK	+44 1332-32651	
	Hong Kong	(852) 833-5188	
	Ascend Systems Inc.	USA	(510) 606-2000 (800) 541-3526 +43 2772-54581
		Austria/ Germany	
France		+33 148619528	
BP Microsystems	USA	(800) 225-2102 (713) 688-4600	
	Canada	(905) 602-8550	
	UK	+44 1280-700262	
	France	+33 16941-2801	
	Germany	+49-8856-932616	
	Hong Kong	852-234-166-11	
	Tokyo	81-3-3817-4980	
Bytek	USA	(407) 994-3520	
	Netherlands, UK, Belgium	+31 16248-0100	
	France	+33 16930-2880	
	Germany	49 6181-75041	
	Hong Kong	852 29198282	
Circuit Equipment Corporation	USA	(216) 951-8840	
	UK	+44 1734-575666	
	France	+33 6185-5767	
Data I/O	USA	(206) 881-6444 (800) 426-1045	
	Canada	(905) 678-0761	
	France	+35 80502-3300	
	Germany	+33-31956-8131	
	Hong Kong	49-89-858-580	
	Japan	81-3-3779-2151	
	Netherlands	+31-402-582-911	
	UK	+44-1734-440011	
E.E. Tools Inc.	USA	(408) 734-8184	
	Canada		
	Mexico	52-5-705-7422	
	France	+33 16930-2880	
	Germany	+49 89834-3047	
	Japan	81-538-322822	
Emulation Technology, Inc.	France	+33 16941-2801	
	USA	(408) 982-0660	
	UK	+44 1234 266455 +44 1962-733140	
	Germany	+49 89-4602071 +49 81-047044	
Logical Devices	USA	(800) 331-7766	
Micro Enhanced Technology (PEP) Programmers	USA	(708) 352-3910	
Nash Electronics	USA	(501) 289-6111	
Needham's Electronics	USA	(916) 924-8037	
Stag Programmers Ltd.	UK	+44-1707-332148	
	USA	(800) 331-7766 (Logical Devices)	
Sunrise Electronics	USA	(909) 595-7774	
System General Corporation	USA	(800) 967-4776 (408) 263-6667	
	Japan	81-3-3441-1510	
	France	+33 2015-1133	
TECI (The Engineers Collaborative Inc.)	Germany	+41 1982-2050	
	USA	(800)-336-8321 (802) 525-3458	
Tribal Microsystems, Inc.	USA	(510) 623-8859	
	Asia	886-2-764-0215	
Vel Electronic	Germany	+49 851-751427	
ICE/Evaluation Boards			
American Arium	USA	(714) 731-1661	
Ashling Microsystems	USA	(508) 366-3220 (Eastern Systems)	
	UK	+44 1628-773070	
	France	+33 14666-2750	
	Germany	+49 8233-32681	
Dr. Krohn & Stiller	Germany	+49 896100-0022	
	UK	+44 1235-861461	
	USA	(320) 617-9400	
Emulation Technology, Inc.	France	+33 16941-2801	
	USA	(408) 982-0660	
	UK	+44 1234-266455 +44 1962-733140	
	Germany	+49 89460-2071 +49 8104-7044	
iSystem GmbH	Germany	+49 8131-25083	
	USA	(408) 982-0660 (Emulation Technology Inc)	
	France	+33 62-072-954 (ISIT Societe)	
Lauterbach, Inc	USA	(508) 620-4521	
	UK	(01254) 682092 (Noral Micrologics Ltd.)	
	Australia	(2) 6541873 (Electro Optics)	
	Germany	(08104) 8943-28	
	France	(1) 39899622 (Logic Instrument)	
MetaLink Corporation	USA	(602) 926-0797	
	UK	+44 1491-455907	
	Canada	(613) 226-2365	
	Hong Kong	896-2-501-6699	
	Germany	+49 8091-55950	
	France	+33 1-39-3956-8131	

Orion Instruments	USA	(408) 747-0440
	Canada	(416) 609-8396 (Multitest Elect. Inc.)
	France	+33 1-30-54-2222 (BSO France S.A.)

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Pentica Systems	USA	(800) PENTICA (617) 275-4419
	UK	+44 0734-792101
	Germany	+49 7147-3085

Sophia Systems	Japan	(044) 989-7000
	USA	(800) 824-9294

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Vel Electronic	Germany	+49 85175-1427
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Yokogawa Digital	Japan	81-422-56-9101
Computer Corp	USA	(408) 747-0400 (Orion Instruments)



Assemblers/Linkers/Debuggers		
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2500 Software Inc.	USA	(719) 395-8683
	France	+33 7443-8045 (CK Electronique) +33 6185-1914 (Societe L.S.I.T.)
	UK	+44 1364-654100 (Greymatter) +44 17183-31022 (System Science)
American Arium	USA	(714) 731-1661
Archimedes Software, Inc.	USA	(206) 822-6300
Avocet Systems, Inc.	USA	(207) 236-9055 (800) 448-8500
BSO Tasking	USA	(617) 894-7800 (800) 458-8276
	France	+33 1-3054-2222
	UK	+44 1252-510014
	Germany	+49 71-5222090
Byte Craft Ltd.	USA	(519) 888-6511
Cosmic Software	USA	(617) 932-2556
	Europe/Intnl	+33 143-995390
	UK	+44 1734-880241
HIWARE	USA	(206) 827-4832 (Archimedes)
	France	+33 16013-3668 (CK Electronique Avnet Group)
	Germany	+41 61331-7151 (HIWARE) +49 7031-2895-38 (Diessner)
	UK	+44 1734-792101 (Pentica) +44 1962-733140 (Nohau)
	Japan	81 3-3293-4716 (Lifeboat)
IAR Systems	USA/ Canada	(415)-765-5500
	Germany	+49 89470-6022
	UK	+44 171924-3334
	France	+1-39-61-14-14
	Hong Kong	2687-1931
Japan	03-293-4711 (Lifeboat)	
Introl Corp.	USA	(414) 327-7171 (800) 327-7171
	UK	+44 171-8331022 (System Science)
	France	+33 7443-8045 (CK Electronique) +33 14622-9988 (Micro Sigma S.A.)
	Japan	(81) 3 256 5881 (Soft Mart Inc.)
	Germany	+49 8104-9074 (Lauterbach GmbH)

P & E Microcomputer Systems, Inc USA (617) 353-9206

PseudoCorp	USA	(541) 683-9173
Software Development Systems (SDS)	USA	(708) 368-0400
	UK	+44 1442-876065
	Japan	+81 (0) 3 3493 7981
	Asia-Pac.	+61 (0) 3 720 5344
	Germany	+49 2534-800170 (H S P GmbH)

TECI (The Engineers Collaborative Inc.) USA (802) 525-3458  
(800) 336-8321

Compiler/Real-Time Kernel		
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Archimedes Software, Inc.	USA	(206) 822-6300
Avocet Systems, Inc.	USA	(207) 236-9055 (800) 448-8500
BSO Tasking	USA	(617) 894-7800 (800) 458-8276
	France	+33 1-30542222
	UK	+44 1252-510014
	Germany	+49 71-5222090
Byte Craft Ltd.	USA	(519) 888-6511
Cosmic Software	USA	(617) 932-2556
	Europe/Intnl	+33 143-995390
	UK	+44 1734-880241
Embedded System Products, Inc.	USA	(713) 728-9688
	Europe	+33-143-995-390 (Cosmic Software)
Hi-Tech (distributed by Avocet in USA)	UK	+44-0734-792-101 (Pentica)
	Germany	+49-7147-3085 (Pentica)
HIWARE	USA	(206) 827-4832 (Archimedes)
	France	+33 16013-3668 (CK Electronique Avnet Group)
	Germany	+41 61331-7151 (HIWARE) +49 7031-2895-38 (Diessner)
	UK	+44 1734-792101 (Pentica) +44 1962-733140 (Nohau)
	Japan	81 33293-4716 (Lifeboat)

<b>Miscellaneous Software and Hardware Support</b>		
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AMP Incorporated (sockets)	USA	(717) 564-0100 (800) 522-6752
	Canada	(905) 475-6222
	Mexico	(525) 729-0400
	Europe	+44 1753-676-800
	Asia/Pacific	(81) 44-813-8502
<hr/>		
McKenzie (now part of Berg Electronics) (adapters, sockets)	USA	(510) 6512700
	Germany	+49 89150-1001 (Infracron GmbH)
	France	+33 14594-1424 (Green Components)
	UK	+44 1295-271777 (Toby Electronics) +44 1501-44434 (Neltronic Ltd.)

Emulation Technology, Inc. (adapters)	France	+33 16941-2801
	USA	(408) 982-0660
	UK	+44 1234 266455 +44 1962-733140
	Germany	+49 89-4602071 +49 81-047044
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USAR Incorporated (keyboard encoders)	USA	(212) 226-2042
<hr/>		
Yamaichi Elec. Inc. (sockets)	USA	(408) 456-0797

# On-Line Help

## CSIC Microcontroller Division World Wide Web Site

[http://design-net.com/csic/CSIC\\_home.html](http://design-net.com/csic/CSIC_home.html)

The CSIC WWW pages provide a direct line to the latest information and software for 68HC05 and 68HC08 microcontrollers. The web site provides access to:

- The Latest News and Press Releases
- Product, Market, and Development Tool Overviews
- On-Line MCU and Development Tool Selector Guides
- On-Line Datasheets and Application Notes
- Development Tool Software Upgrades
- Free Development Software
- Applications Software
- 3rd Party Development Tool Information
- On-Line Technical Support

## Freeware Bulletin Board

The Freeware Data Services are now mirrored on the CSIC WWW site for easy access. Customers unable to access the Internet can still access the Freeware development software and applications software by dial-up modem at 2400 to 9600 baud. To log in:

1. Make sure to set character format to 8-bits, no parity, 1 stop bit
2. Dial (512) 891-FREE (512-891-3733)
3. Follow directions from the system

The Freeware files are also accessible by anonymous FTP server:

`freeware.aus.mot.com`  
(use email address for password)



# Single-Chip Microcontrollers (AMCU)

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## In Brief . . .

Motorola offers the most comprehensive selection of high-performance single-chip control systems available from a single source. Microcontroller device families range from industry-standard 8-bit controllers to state-of-the-art 16- and 32-bit modular controllers. Within the price and performance categories of each family, there are a variety of on-chip capabilities to match specific applications.

Motorola device families are structured so that upward migration need not involve complete code development. The M68HC11 Family is upward code compatible with M6800 and M6801 software, while the M68HC16 family is source-code compatible with the M68HC11 family. Motorola's newest 8-bit MCU product line, the M68HC08 family, is fully upward object code compatible with the M68HC05 and M6805 families. In addition, M68300 and M68HC16 devices share standard internal modules and bus configurations.

	<b>Page</b>
M68HC11 Family . . . . .	2.6-2
Modular Microcontroller . . . . .	2.6-12
The M68HC16 Family . . . . .	2.6-14
The M68300 Family . . . . .	2.6-19
Development Tools . . . . .	2.6-23
Fuzzy Logic . . . . .	2.6-26
On-Line Help . . . . .	2.6-26
Third-Party Support . . . . .	2.6-27

# M68HC11 Family

The M68HC11 Family incorporates a flexible central processing unit and a large number of control-oriented on-chip peripherals. M68HC11 MCU are upward code compatible with M6800, M6801, and M68HC05 software.

## Central Processing Unit

The M68HC11 CPU is optimized for low power consumption and high-performance operation at bus frequencies up to 4 MHz. Key features include:

- Two 8-bit or one 16-bit accumulator
- Two 16-bit index registers
- Powerful bit-manipulation instructions
- Six powerful addressing modes
  - Immediate, Extended, Direct, Indexed, Inherent, and Relative
- Power saving STOP and WAIT modes
- Memory mapped I/O and special functions
- 16x16 Integer and Fractional Divides
- 8x8 Multiply

## Timer

M68HC11 timer architecture is based on a 16-bit free running counter driven through a software-programmable prescaler. Features include multiple Input Captures, Output Compares, Real-Time Interrupt, Pulse Accumulator, and Watchdog functions.

## On-Chip Memory

Since its introduction, the M68HC11 Family has provided versatile combinations of popular memory technologies, including the first EEPROM on a CMOS microcontroller. The family has a memory option to fit virtually any application.

- ROM sizes range from 0 to 32K bytes. ROM is typically factory programmed to contain custom software. ROMless versions of most M68HC11 Family members are also available.
- RAM sizes range from 192 bytes to 1.25K bytes. M68HC11 RAM utilizes a fully static design, and all devices feature a standby power supply pin for battery back-up of RAM contents.
- EPROM sizes range from 4K to 32K bytes. EPROM is especially suited to prototype development and small production runs. EPROM versions are available in both windowed and OTP packaging.
- EEPROM sizes range from 0 to 2K bytes. EEPROM is ideal for storage of calibration, diagnostic, data logging, and security information. Each M68HC11 device with EEPROM includes an on-chip charge pump to facilitate single-supply programming and erasing.

## Digital-to-Analog Conversion

The M68HC11 Family provides powerful, on-chip, multi-channel A/D converter systems. Multi-conversion and multi-channel options allow single or continuous conversion on single or multiple channels. M68HC11 A/D systems have

eight input channels, and most offer 8-bit resolution, although some provide 10-bit resolution. A 2 channel, 8-bit D/A is also available.

## Pulse-Width Modulation

Some M68HC11 Family members have up to six channels of 8-bit PWM. At a 4 MHz bus frequency, signals can be produced from 40 KHz to less than 10 Hz. PWM signals with a period greater than one minute are possible in the 16-bit mode.

## Serial Communication

All members of the M68HC11 Family include a Serial Peripheral Interface (SPI) and a Serial Communications Interface (SCI). These on-chip peripherals are designed to minimize CPU intervention during data transfer.

- The SCI is a full duplex UART-type asynchronous system that uses standard Non-Return-to-Zero (NRZ) data format. An on-chip Baud rate generator derives standard rates from the microcontroller oscillator. Both transmitter and receiver are double buffered.
- The SPI is a four-wire synchronous communications interface used for high-speed communication with specialized peripheral devices and other microcontrollers. Data is transmitted and received simultaneously; the Baud rate is software programmable.

## Digital I/O and Special Functions

M68HC11 Family I/O is extremely flexible, allowing pins to be configured to match application requirements. Most I/O lines are controlled by bits in a Data Direction Register (DDR) which can configure pins for either input or output. Most lines have a dedicated port data latch.

Some M68HC11 Family members include a 4-channel Direct Memory Access (DMA) and a Memory Management Unit (MMU). The DMA provides fast data transfer between memories and registers, and includes externally mapped memory in the expanded mode. The MMU allows up to 1 megabyte of address space in a physical 64 kbyte allocation. Integrated chip selects help to reduce glue logic.

Several members of the M68HC11 Family also include programmable chip select circuits. These circuits can be used to enable external peripherals whenever an access to a predefined block of memory addresses is made. These circuits help to reduce external logic requirements.

## Math Coprocessor

New M68HC11 Family members offer a 16-bit on-chip math coprocessor that accelerates multiply and divide operations by as much as 10 times. The coprocessor functions independently of the CPU and requires no special instructions. The coprocessor is well-suited to low-bandwidth DSP functions such as closed loop control, servo positioning, and signal conditioning.

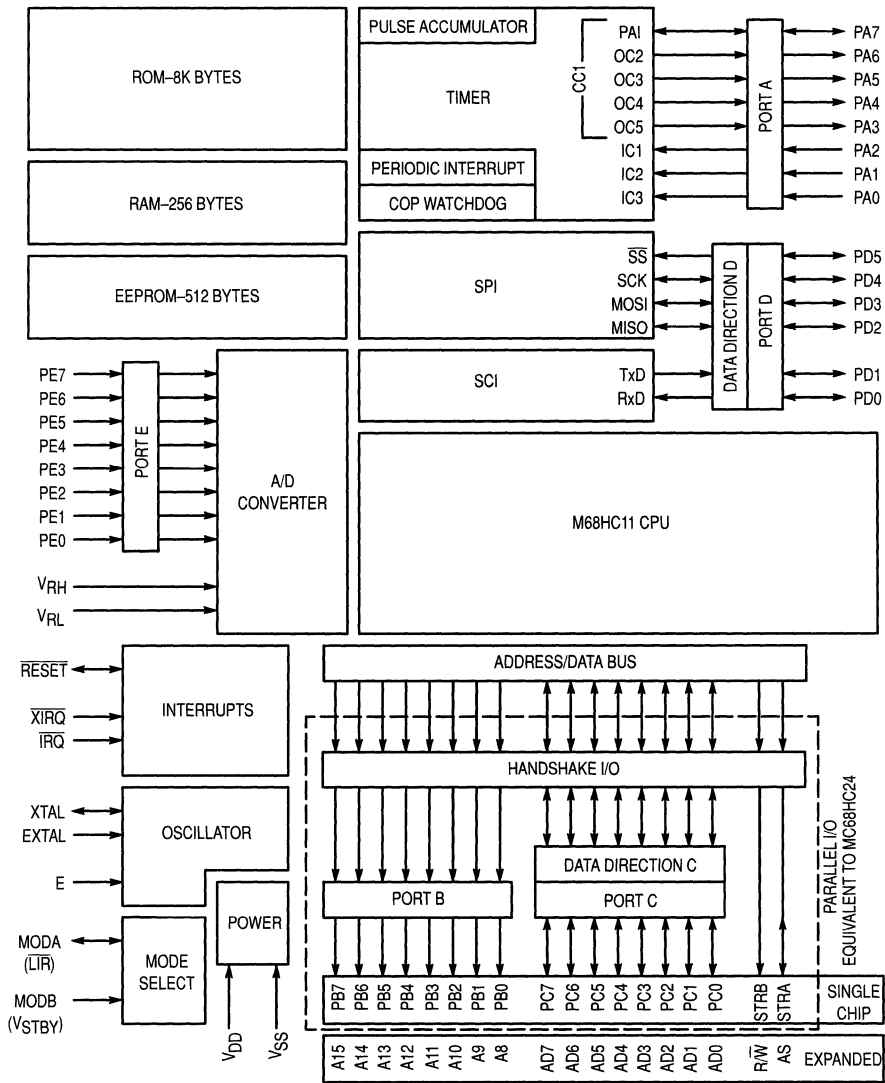


Figure 1. MC68HC11A8 Block Diagram

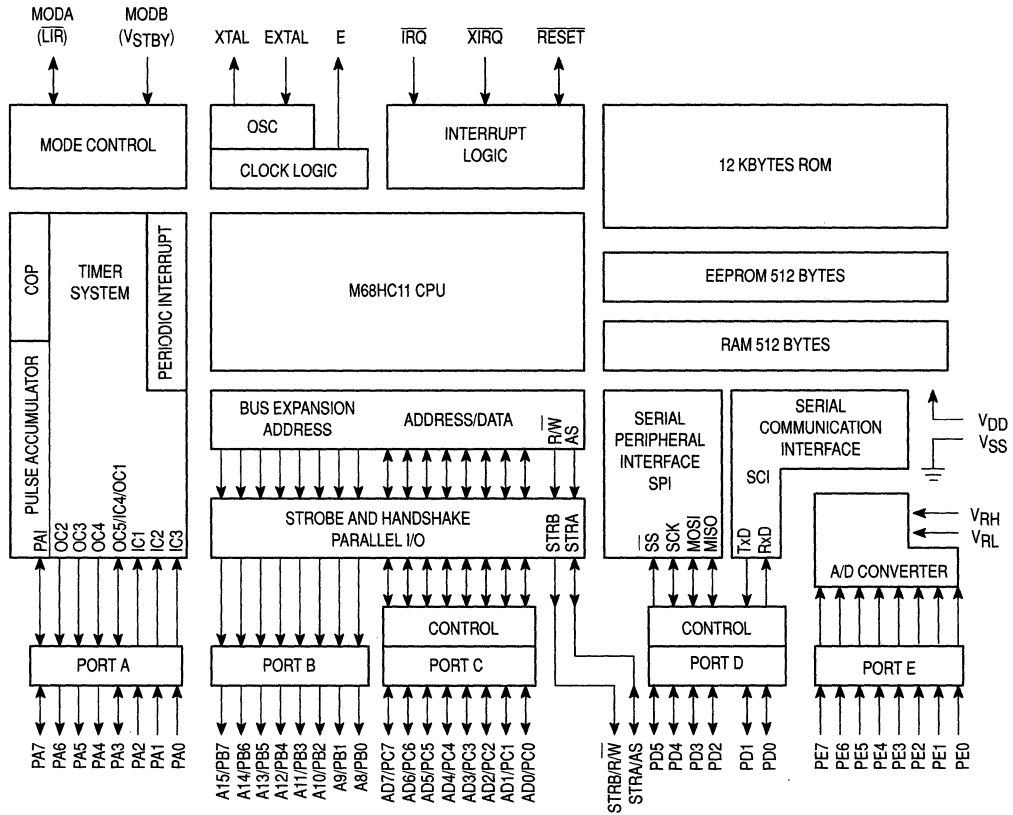


Figure 2. MC68HC11E9 Block Diagram



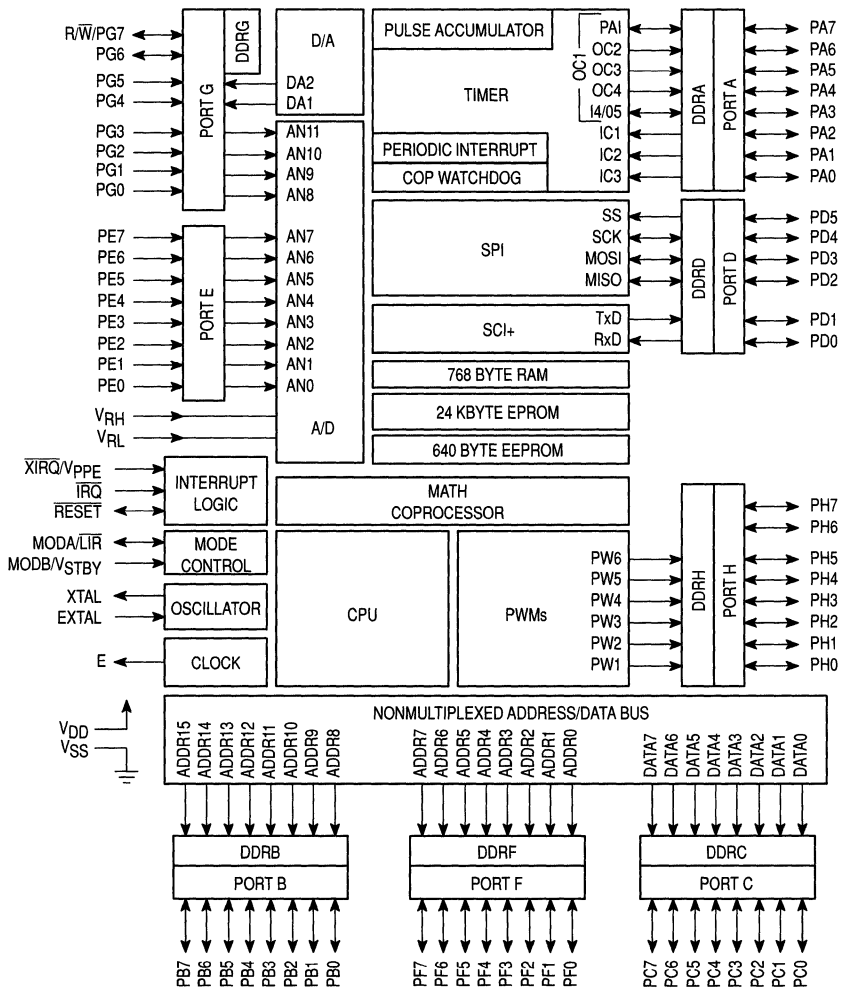


Figure 3. MC68HC711N4 Block Diagram

**Table 1. M68HC11 Family Microcontrollers**

Part Number	EPROM	RAM	EEPROM	Timer	I/O	Serial	A/D	PWM	Package	Comments
MC68HC11A0	-	256	-	16-Bit - 3 IC, 5 OC, RTI, WDOG Pulse Accumulator	22	SPI, SCI	8 Ch, 8-Bit	-	52-FN 64-FU 48-P	64K External Address Bus, 68HC24 PRU, 3.0 V Version Available
MC68HC11A1	-	256	512	16-Bit - 3 IC, 5 OC, RTI, WDOG Pulse Accumulator	22	SPI, SCI	8 Ch, 8-Bit	-	52-FN 64-FU 48-P	64K External Address Bus, 68HC24 PRU, 3.0 V Version Available
MC68HC11A7	8K	256	-	16-Bit - 3 IC, 5 OC, RTI, WDOG, Pulse Accumulator	38	SPI, SCI	8 Ch, 8-Bit	-	52-FN 64-FU 48-P	3 MHz Version Available, 64K External Address Bus, 68HC24 PRU, 3.0 V Version Available
MC68HC11A8	8K	256	512	16-Bit - 3 IC, 5 OC, RTI, WDOG, Pulse Accumulator	38	SPI, SCI	8 Ch, 8-Bit	-	52-FN 48-P	3 MHz Version Available, Low Voltage Version (3.0-5.5V) at 2 MHz, 64K External Address Bus, 68HC24 PRU
XC68HC11C0	-	256	512	16-Bit - 3/4 IC, 4/5 OC, RTI, WDOG, Pulse Accumulator	36	SPI, SCI	4 Ch, 8-Bit	2 Ch, 8-Bit	68-FN 64-FU	256K Extended Memory, 6 Chip Selects
MC68HC11D0	-	192	-	16-Bit - 3/4 IC, 4/5 OC, RTI, WDOG, Pulse Accumulator	14	SPI, SCI	-	-	44-FB 44-FN 40-P	64K External Address Bus, 68HC27 PRU, 3.0V Version Available
MC68HC11D3	4K	192	-	16-Bit - 3/4 IC, 4/5 OC, RTI, WDOG, Pulse Accumulator	32	SPI, SCI	-	-	44-FB 44-FN 40-P	3 MHz Version Available, Low Voltage Version (3.0-5.5V) at 2 MHz, 64K External Address Bus, 68HC27 PRU
MC68HC11ED0	-	512	-	16-Bit - 3/4 IC, 4/5 OC, RTI, WDOG, Pulse Accumulator	30	SPI, SCI	-	-	44-FB 44-FN 40-P	Pin Compatible with 68HC11D3
MC68HC11E0	-	512	-	16-Bit - 3/4 IC, 4/5 OC, RTI, WDOG, Pulse Accumulator	22	SPI, SCI	8 Ch, 8-Bit	-	52-FN	64K External Address Bus, 68HC24 PRU, 3.0 V Version Available
MC68HC11E1	-	512	512	16-Bit - 3/4 IC, 4/5 OC, RTI, WDOG, Pulse Accumulator	22	SPI, SCI	8 Ch, 8-Bit	-	52-FN 64-FU	64K External Address Bus, EEPROM Block Protect, 68HC24 PRU, 3.0 V Version Available
MC68HC11E8	12K	512	-	16-Bit - 3/4 IC, 4/5 OC, RTI, WDOG, Pulse Accumulator	38	SPI, SCI	8 Ch, 8-Bit	-	52-FN	3 MHz Version Available, 64K External Address Bus, 3.0 V Version Available
MC68HC11E9	12K	512	512	16-Bit - 3/4 IC, 4/5 OC, RTI, WDOG, Pulse Accumulator	38	SPI, SCI	8 Ch, 8-Bit	-	52-FN 64-FU	EEPROM Block Protect, 3 MHz Version Available, Low Voltage Version (3.0-5.5V) at 2 MHz, 64K External Address Bus
XC68HC11E20	20K	768	512	16-Bit - 3/4 IC, 4/5 OC, RTI, WDOG, Pulse Accumulator	38	SPI, SCI	8 Ch, 8-Bit	-	52-FN 64-FU	3 MHz Mux Bus
MC68HC811E2	-	256	2048	16-Bit - 3/4 IC, 4/5 OC, RTI, WDOG, Pulse Accumulator	38	SPI, SCI	8 Ch, 8-Bit	-	52-FN	EEPROM Block Protect, 64K External Address Bus, 68HC24 PRU
MC68HC11F1	-	1K	512	16-Bit - 3/4 IC, 4/5 OC, RTI, WDOG, Pulse Accumulator	54	SPI, SCI	8 Ch, 8-Bit	-	68-FN 80-FU	Programmable Chip Selects, EEPROM Block Protect, 64K External Address Bus, 68HC27 PRU, 4 MHz Non-Mux Address/Data Bus

**Table 1. M68HC11 Family Microcontrollers (continued)**

Part Number	EPROM	RAM	EEPROM	Timer	I/O	Serial	A/D	PWM	Package	Comments
PC68HC11G0	-	-	512	16-Bit - 3/4 IC, 4/5 OC, RTI, WDOG, Pulse Accumulator	38	SPI, SCI	8 Ch, 10-Bit	4 Ch, 8-Bit	84-FN 80-FU	
PC68HC11G5	16K	512	-	16-Bit - 3/4 IC, 4/5 OC, RTI, WDOG, Pulse Accumulator	66	SPI, SCI	8 Ch, 10-Bit	4 Ch, 8-Bit	84-FN 80-FU	
PC68HC11G7	24K	512	-	16-Bit - 3/4 IC, 4/5 OC, RTI, WDOG, Pulse Accumulator	66	SPI, SCI	8 Ch, 10-Bit	4 Ch, 8-Bit	84-FN 80-FU	
PC68HC11J6	16K	-	512	16-Bit - 3/4 IC, 4/5 OC, RTI, WDOG, Pulse Accumulator	29	SPI, SCI	8 Ch, 8-Bit	4 Ch, 8-Bit	84-FN 80-FU	
MC68HC11K0	-	768	-	16-Bit - 3/4 IC, 4/5 OC, RTI, WDOG, Pulse Accumulator	37	SPI, SCI	8 Ch, 8-Bit	4 Ch, 8-Bit	84-FN 80-FU	4 MHz Non-Mux Address/Data Bus, Chip Selects, Extended Memory Map, 68HC27 PRU, 3.0 V Version Available
MC68HC11KA0	-	768	-	16-Bit - 3/4 IC, 4/5 OC, RTI, WDOG, Pulse Accumulator	26	SPI, SCI	8 Ch, 8-Bit	4 Ch, 8-Bit	68-FN 64-FU	4 MHz Non-Mux Address/Data Bus, Chip Selects, Extended Memory Map, 68HC27 PRU
MC68HC11K1	-	768	640	16-Bit - 3/4 IC, 4/5 OC, RTI,WDOG, Pulse Accumulator	37	SPI, SCI	8 Ch, 8-Bit	4 Ch, 8-Bit	84-FN 80-FU	4 MHz Non-MuxBus,Chip Selects, EEPROM Block Protect, Extended Memory Map, 68HC27 PRU, 3.0 V Version Available
MC68HC11KA1	-	768	640	16-Bit - 3/4 IC, 4/5 OC, RTI,WDOG, Pulse Accumulator	26	SPI, SCI	8 Ch, 8-Bit	4 Ch, 8-Bit	68-FN 64-FU	4 MHz Non-Mux Address/Data Bus, Chip Selects,EEPROM Block Protect, Extended Memory Map, 68HC27 PRU
MC68HC11K3	24K	768	-	16-Bit - 3/4 IC, 4/5 OC, RTI, WDOG, Pulse Accumulator	62	SPI, SCI	8 Ch, 8-Bit	4 Ch, 8-Bit	84-FN 80-FU	4 MHz Non-Mux Address/Data Bus, Chip Selects, Extended Memory Map, 68HC27 PRU, 3.0V Version Available
MC68HC11KA3	24K	768	-	16-Bit - 3/4 IC, 4/5 OC, RTI, WDOG, Pulse Accumulator	51	SPI, SCI	8 Ch, 8-Bit	4 Ch, 8-Bit	68-FN 64-FU	4 MHz Non-Mux Address/Data Bus, Chip Selects, Extended Memory Map, 68HC27 PRU
MC68HC11K4	24K	768	640	16-Bit - 3/4 IC, 4/5 OC, RTI, WDOG, Pulse Accumulator	62	SPI, SCI	8 Ch, 8-Bit	4 Ch, 8-Bit	84-FN 80-FU	4 MHz Non-Mux Bus, Low Voltage Version (3.0-5.5V) at 3 MHz, Chip Selects, EEPROM Block Protect, Extended Memory Map, 68HC27 PRU
MC68HC11KA4	24K	768	640	16-Bit - 3/4 IC, 4/5 OC, RTI, WDOG, Pulse Accumulator	51	SPI, SCI	8 Ch, 8-Bit	4 Ch, 8-Bit	68-FN 64-FU	4 MHz Non-Mux Address/Data Bus, Chip Selects, EEPROM Block Protect
MC68HC11L0	-	512	-	16-Bit - 3/4 IC, 4/5 OC,RTI, WDOG, Pulse Accumulator	30	SPI, SCI	8 Ch, 8-Bit	-	68-FN 64-FU	64K External Address Bus, 68HC24 PRU, 3.0 V Version Available
MC68HC11L1	-	512	512	16-Bit - 3/4 IC, 4/5 OC,RTI, WDOG, Pulse Accumulator	46	SPI, SCI	8 Ch, 8-Bit	-	68-FN 64-FU	64K External Address Bus, EEPROM Block Protect, 68HC24 PRU, 3.0 V Version Available
MC68HC11L5	16K	512	-	16-Bit - 3/4 IC, 4/5 OC, RTI, WDOG, Pulse Accumulator	46	SPI, SCI	8 Ch, 8-Bit	-	68-FN 64-FU	64K External Address Bus, 68HC24 PRU, 3.0 V Version Available

**Table 1. M68HC11 Family Microcontrollers (continued)**

Part Number	EPROM	RAM	EEPROM	Timer	I/O	Serial	A/D	PWM	Package	Comments
MC68HC11L6	16K	512	512	16-Bit – 3/4 IC, 4/5 OC, RTI, WDOG, Pulse Accumulator	46	SPI, SCI	8 Ch, 8-Bit	–	68-FN 64-FU	3 MHz Version Available, Low Voltage Version (3.0–5.5V) at 2 MHz, 64K External Address Bus, 68HC24 PRU
MC68HC11M2	32K	1.25K	–	16-Bit – 3/4 IC, 4/5 OC, RTI, WDOG, Pulse Accumulator	62	SPI, 2-SCI	8 Ch, 8-Bit	4 Ch, 8-Bit	84-FN 80-FU	16-Bit Math Coprocessor, 4 MHz Non-Mux Bus, 4 Ch DMA Controller
XC68HC11N4	24K	768	640	16-Bit – 3/4 IC, 4/5 OC, RTI, WDOG, Pulse Accumulator	62	SPI, SCI	12 Ch, 8-Bit	6 Ch, 8-Bit	84-FN 80-QFP	16-Bit Math Coprocessor, 4 MHz Non-Mux Bus, 2 Ch 8-Bit D/A
XC68HC11P2	32K	1K	640	16-Bit – 3/4 IC, 4/5 OC, RTI, WDOG, Pulse Accumulator	62	SPI, 3-SCI	8 Ch, 8-Bit	4 Ch, 8-Bit	84-FN 80-FU	PLL Clock Option

**Table 2. M68HC11 One-Time Programmable/Emulator Microcontrollers**

Part Number	EPROM	RAM	EEPROM	Timer	I/O	Serial	A/D	PWM	Package	Comments
PC68HC711D3	4K	192	–	16-Bit – 3/4 IC, 4/5 OC, RTI, WDOG, Pulse Accumulator	32	SPI, SCI	–	–	44-FB 44-FN 40-P	64K External Address Bus
PC68HC711E9	12K	512	512	16-Bit – 3/4 IC, 4/5 OC, RTI, WDOG, Pulse Accumulator	38	SPI, SCI	8 Ch, 8-Bit	–	52-FN 64-FU	EEPROM Block Protect, 64K External Address Bus
PC68HC711E20	20K	768	512	16-Bit – 3/4 IC, 4/5 OC, RTI, WDOG, Pulse Accumulator	38	SPI, SCI	8 Ch, 8-Bit	–	52-FN 52-FS 64-FU	EEPROM Block Protect, 64K External Address Bus
PC68HC711G5	16K	512	–	16-Bit – 3/4 IC, 4/5 OC, RTI, WDOG, Pulse Accumulator	66	SPI, SCI	8 Ch, 10-Bit	4 Ch, 8-Bit	84-FN 84-FS	
PC68HC711J6	16K	512	–	16-Bit – 3/4 IC, 4/5 OC, RTI, WDOG, Pulse Accumulator	54	SPI, SCI	–	–	68-FN 68-FS	1 Chip Select
PC68HC711K4	24K	768	640	16-Bit – 3/4 IC, 4/5 OC, RTI, WDOG, Pulse Accumulator	62	SPI, SCI	8 Ch, 8-Bit	4 Ch, 8-Bit	84-FN 84-FS 80-FU	4 MHz Non-Mux Bus, EEPROM Block Protect, Chip Selects, Extended Memory Map
PC68HC711L6	16K	512	512	16-Bit – 3/4 IC, 4/5 OC, RTI, WDOG, Pulse Accumulator	46	SPI, SCI	8 Ch, 8-Bit	–	68-FN 68-FS 64-FU	EEPROM Block Protect, 64K External Address Bus
PC68HC711M2	32K	1.25K	–	16-Bit – 3/4 IC, 4/5 OC, RTI, WDOG, Pulse Accumulator	62	SPI, SCI	8 Ch, 8-Bit	–	84-FN 84-FS 80-FU	16-Bit Math Coprocessor, 4 MHz Non-Mux Bus, 4 Ch DMA Controller
PC68HC711N4	24K	768	640	16-Bit – 3/4 IC, 4/5 OC, RTI, WDOG, Pulse Accumulator	62	SPI, SCI	12 Ch, 8-Bit	6 Ch, 8-Bit	84-FN 84-FS	16-Bit Math Coprocessor, 4 MHz Non-Mux Bus, 2 Ch 8-Bit D/A
XC68HC711P2	32K	1K	640	16-Bit – 3/4 IC, 4/5 OC, RTI, WDOG, Pulse Accumulator	62	SPI, SCI	8 Ch, 8-Bit	4 Ch, 8-Bit	84-FN 84-FS 88-FU	PLL Clock

### Definitions for Tables 3 and 4

#### General Definitions

#### Package Definitions

ADC	Analog to Digital Converter Module
A/D	Analog to Digital Converter
CPU16	16 bit Central Processing Unit
CPU32	32 bit Central Processing Unit
D/A	Digital to Analog Converter
DMA	Direct Memory Access
GPT	General-Purpose Timer
IC	Input Capture
IIC	Inter-Integrated Circuit
MCCI	Multi-Channel Communication Interface
PLL	Phase Lock Loop
OC	Output Capture
POQ	Preferred Order Quantity Multiple
PWM	Pulse Width Modulation
QSM	Queued Serial Module
RPSCIM	Reduced Pin Count SCIM
RTC	Real-Time Clock
RTI	Real-Time Interrupt
SCI	Serial Communication Interface
SCIM	Single Chip Integration Module
SIM	System Integration Module
SPI	Serial Peripheral Interface
TPU	Time Processing Unit
UART	Universal Asynchronous Receiver/Transmitter
WDOG	Watch Dog Timer

FB	10x10 mm Quad Flat Pack (QFP)
FC	Fine Pitch Plastic Quad Flat Pack (PQFP)
FD	Plastic Quad Flat Pack in Molded Carrier Ring
FE	Ceramic Quad Flat Pack (CQFP)
FM	Molded Carrier Flat Pack (CQFP)
FN	Plastic Leaded Chip Carrier (PLCC)
FS	Windowed Cerquad (Ceramic LCC)
FT	28x28 mm Quad Flat Pack (QFP)
FU	14x14 mm Quad Flat Pack (QFP)
FV	20x20 mm Quad Flat Pack (QFP)
L	Ceramic
P	Dual-in-Line Plastic
PB	Thin Quad Flat Pack (TQFP) 10x10 mm
PU	Thin Quad Flat Pack (TQFP) 14x14 mm
PV	Thin Quad Flat Pack (TQFP) 20x20mm
S	Cerdip (windowed or non-windowed)
TH	16x16 mm Quad Flat Pack (QFP)

# M6800 Series Microprocessors and Peripherals

These devices are a testament to the staying power of Motorola microtechnology. The original MC6800 was introduced in 1975, and is still in demand today. Quality M6801, M6804 and M6805 systems have been performing

reliably in automotive, industrial, and office equipment applications for years. Each of these devices can be combined with various peripherals to meet the requirements of a microcontroller design.

**Table 3. M6801 and M6803 (HMOS)**

Part Number	ROM	RAM	EEPROM	Timer	Serial	A/D	I/O	Bus Speed, MHz	Package	Comments
MC6801	2048	192	0	16 bit: 1 IC, 1 OC	SCI	No	29	0.5–2.0	40 P	
MC68701	0	128	2048	16 bit: 1 IC, 1 OC	SCI	No	29	0.5–2.0	40 P	
MC6803	0	192	0	16 bit: 1 IC, 1 OC	SCI	No	13	0.5–2.0	40 P	
MC6801U4	4096	256	0	16 bit: 2 IC, 3 OC	SCI	No	29	0.5–1.25	40 P	
MC68701U4	0	128	4096	16 bit: 2 IC, 3 OC	SCI	No	29	0.5–1.25	40 P	
MC6803U4	0	256	0	16 bit: 2 IC, 3 OC	SCI	No	13	0.5–1.25	40 P	

**Table 4. 8–Bit MPU/Peripherals**

Device	Pins	Package	Part Description	Speed
MC68B00	40	P	8 Bit MPU, Addresses 64K Memory, 1 or 2 MHz Versions	2 MHz
MC6802	40	P	MC6800 + Int. Clock Oscillator; 128 Bytes RAM	1 MHz
MC68B09	40	P	High Performance MPU, 10 Powerful Addressing Modes	2 MHz
MC68B09E	40	P	MC6809 With External Clock Input for External Sync.	2 MHz
MC68B21	40	P	Peripheral Interface Adapter	2 MHz
MC68B40	40	P	Programmable Timer Module Contains 3 16–Bit Timers	2 MHz
MC6845	40	P	CRT Ctrl, Refresh Memory Addressing; 2nd Source HD6845R	1 MHz
MC68B50	40	P	Asynchronous Communication Interface Adaptor	2 MHz
MC68HC24	40, 44	P, FN	MC68HC11 Port Replacement (Expanded Mode) for A8, E9	2 MHz
MC68HC27	46, 68	FU, FN	Port Replacement for D3, K4, F1	2 MHz
MC68HCB34	40	P, FN	256 Byte Dual Port RAM, 6 Semaphore Registers	2 MHz
MC68B10	24	P	128 x 8 Random Access Memory	2 MHz
MC68B44	40	P	Direct Memory Access Controller	2 MHz
MC68B488	40	P	General Purpose Interface Adapter	2 MHz
MC68B52	24	P	Synchronous Serial Data Adapter	2 MHz
MC68B54	28	P	Advanced Data Link Controller	2 MHz

**Table 5. M6805 (HMOS) Microprocessors**

Part Number	ROM	RAM	EEPROM	Timer	Serial	A/D	I/O	Bus Speed, MHz	Package	EPROM or EEPROM Version	Comments
MC6805P2	1K	64	0	8-Bit	–	No	20	0.1–1.0	28–P 28–FN	705P3	LVI Option
MC6805P6	2K	64	0	8-Bit	–	No	20	0.1–1.0	28–P	705P3	LVI Option
MC6805R2	2K	64	0	8-Bit	–	Yes	32	0.1–1.0	40–P 44–FN	705R3	LVI Option, Prog. Prescaler Option
MC6805R3	4K	112	0	8-Bit	–	Yes	32	0.1–1.0	40–P 44–FN	705R3	7-Bit Prescaler, LVI Option
MC6805R6	4K	112	0	8-Bit, WDOG	–	Yes	32	0.1–1.0	40–P 44–FN	705R3	7-Bit Prescaler, LVI Option
MC6805S2	1K	64	0	16-Bit, 8-Bit	SPI	Yes	16	0.1–1.0	28–P	705S3	15-Bit Prescaler, LVI
MC6805S3	4K	104	0	2 8-Bit, 16-Bit	SPI	Yes	21	0.1–1.0	28–P	705S3	1 Extra 8-Bit Timer
MC6805U2	2K	64	0	8-Bit	–	No	32	0.1–1.0	40–P 44–FN	705U3	LVI Option
MC6805U3	4K	112	0	8-Bit	–	No	32	0.1–1.0	40–P 44–FN	705U3	7-Bit Prescaler, LVI Option

**Table 6. 8-Bit MPU/Peripherals**

Device	Pins	Package	Part Description
MC14618	24	P	Real Time Clock, 50 Bytes RAM, Programmable Square Wave
MC146818A	24, 28	P, FN	Enhanced Version of the MC146818
MC146823	40, 44	P, FN	Three 8-Bit Ports, Handshake Control Logic
MC146805E2	40, 44	P, FN	CMOS 8-Bit Microprocessor
MC68HC68L9	80	FU	LCD Expansion to the MC05L9

# Modular Microcontrollers

Modular microcontrollers are another of the innovations that make Motorola a leader in single-chip control systems. Modular controllers are built up from standard modules that interface via a common intermodule bus (IMB). The modular concept allows rapid design and manufacture of controllers tailored for specific applications.

## Intermodule Bus Peripherals

Each modular microcontroller incorporates a state-of-the-art pipelined CPU module, a sophisticated integration module, and a number of special-purpose modules. The rapidly-growing library of special-purpose modules includes programmable timers, serial communication interfaces, analog-to-digital converters, and a variety of memory modules.

## Central Processing Units

### CPU16

- 16-Bit Architecture
- Full Set of 16-Bit Instructions
- Three 16-Bit Index Registers
- Two 16-Bit Accumulators
- One Megabyte of Program Memory and One Megabyte of Data Memory
- Source code compatible with the M68HC11 CPU
- Control-Oriented Digital Signal Processing Capability
- High-Level Language Support
- Fast Interrupt Response Time
- Fully Static Implementation
- Low Power Stop Operation
- Background Debugging Mode
- Hardware Breakpoint Signal

### CPU32

- 32-Bit Internal Data Path and Arithmetic Hardware
- 32-Bit Internal Address Bus – 24-Bit External Address Bus
- Eight 32-Bit General-Purpose Data Registers
- Seven 32-Bit General-Purpose Address Registers
- Separate User and Supervisor Stack Pointers and Address Spaces
- Separate Program and Data Address Spaces
- Virtual Memory Implementation
- Enhanced Addressing Modes
- Object Code Compatible with M68000 Family
- Improved Exception Handling for Controller Applications
- Rich Instruction Set
- Fully Static Implementation
- Low Power Stop Operation
- Background Debugging Mode
- Hardware and Software Breakpoints
- Trace on Change of Flow

## Integration Modules

### System Integration Module (SIM)

- Manages controller internal and external bus interfaces
- Provides device interrupt arbitration
- Spurious interrupt monitor

- Twelve programmable chip-select outputs
- Watchdog timer, clock monitor, and bus monitor
- PLL clock synthesizer

### Single-Chip Integration Module (SCIM)

- Manages controller internal and external bus interfaces
- Provides device interrupt arbitration
- Spurious interrupt monitor
- Single-chip operation with address and data bus pins configured as I/O ports
- Optional Fully or Partially-expanded bus operation
- Nine general-purpose chip select outputs
- Emulation mode chip-select outputs can be used to address a port replacement unit and external emulation RAM
- Watchdog timer, clock monitor, and bus monitor
- PLL clock synthesizer
- Interrupt request inputs can be configured for edge or level detection
- Reduced pin SCIM (RPSCIM) available with 5 chip selects

## Timers

### Time Processor Unit (TPU)

- On-chip microengine dedicated to high-speed timing tasks
- Two independent 16-bit counters used as basis for timing tasks
- Real-time task scheduler
- Executes a programmed series of functions to perform complex tasks
- Each of 16 orthogonal channels can perform available time functions
- Functions contained in dedicated control store or in MCU RAM
- TPU communicates to CPU via dual port RAM

### General Purpose Timer (GPT)

- Two 16-bit free-running counters
- Three input capture channels
- Four output compare channels
- One input capture/output compare channel
- One pulse accumulator/event counter input
- Two pulse-width modulation outputs
- Pulse accumulator input

### Configurable Timer Module (CTM)

- Modular timer system combining different configurations of timer submodules:
- CPSM-6 TAP counter prescaler
- FCSM-16-bit free running up counter
- MCSM-16-bit modulus up counter
- SASM-(Single Action) two I/O pins for 16-bit input capture or output compare functions
- DASM-(Dual Action) one I/O pin for 16-bit I/C, O/C, PWM, or output function



## Timer Module (TM)

- 16-bit free-running counter with 8-bit prescaler
- Two TM can be externally cascaded to increase count width
- Software selected input capture, output compare, pulse accumulation, event counting, or pulse-width modulation functions

## Communication Modules

### Queued Serial Module (QSM)

- Queued full-duplex, synchronous three-line SPI with dedicated RAM
- Standard, asynchronous NRZ-format SCI
- Polled and interrupt-driven operation
- Pins can be configured as a parallel I/O port

### Multi-Channel Communications Interface (MCCI)

- One full-duplex synchronous three-line SPI
- Two independent standard, asynchronous NRZ-format SCI
- Polled and interrupt-driven operation
- Pins can be configured as a parallel I/O port

### Dual Universal Asynchronous/Synchronous Receiver Transmitter (DUART)

- Dual NRZ Serial RS-232C channels
- Independently programmable TxD and Receiver Transmitter (DUART)
- RxD Baud rates for each channel up to 76.8K Baud
- Optional external input pins provide baud clock
- Transmit operations are double buffered, and receive operations are quadruple buffered
- RTS and CTS signals are directly supported

## Analog-to-Digital Conversion Modules

### Analog-to-Digital Converter (ADC)

- 8 or 10 bits of resolution
- Eight input channels
- Eight result registers
- Three result alignment formats
- Eight automated conversion modes
- Programmable sample and hold times are provided
- Three result alignment modes

### Queued Analog-to-Digital Converter (QADC)

- 10 bits of resolution
- 16 analog input channels (up to 27 if multiplexed externally)
- Two independent conversion queues
- 32 result registers (16 per queue)
- Three result alignment formats

- Queued conversions can be performed continuously or can be retriggered by software or the QADC module periodic interval timer and external trigger
- Programmable sample and hold times
- Alternate voltage references

## Specialized Control Modules

### Direct Memory Access (DMA)

- Provides low-latency transfer to external peripheral or for memory-memory data transfer
- Two independent DMA channels with full programmability

## Memory Modules

### Standby RAM (SRAM)

- Fast Static RAM maintained by voltage from standby voltage pin
- Available in 1K, 1.5K, 2K, 3.5K, and 4K blocks
- Fast (2 clock) access speed
- Byte, word, and long-word operations supported

### Standby RAM with TPU Emulation (TPURAM)

- Fast Static RAM maintained by voltage from standby voltage pin
- Available in 1K, 1.5K, 2K, 3.5K, and 4K blocks
- Fast termination (2 clock) access speed
- Supports TPU microcode ROM emulation
- Byte, word, and long-word operations supported

### Masked ROM (MRM)

- Custom-masked non-volatile 16-bit wide memory
- Available in 4K increments from 8K to 48K bytes
- Fast (2 clock) access speed
- Byte, word, and long-word operations supported
- Boot ROM capability

### Flash EEPROM (FLASH)

- Word programmable, bulk erasable non-volatile 16-bit wide memory
- Available in 8K increments from 8K to 64K bytes
- Fast (2 clock) access speed
- Byte, word, and long-word operations supported
- Boot ROM capability
- External 12 volt programming/erasure source required

### Block Erasable Flash EEPROM (BEFLASH)

- Available in 8K increments from 8K to 64K bytes
- Eight independently-erasable blocks
- Fast termination (2 clock) access speed
- Byte, word, and long-word operations supported
- Byte/Word programming with 12 volt external input

# The M68HC16 Family

The M68HC16 family is designed for embedded control applications. Each M68HC16 MCU incorporates a true 16-bit CPU module (CPU16) that is upwardly code-compatible with the M68HC11 CPU, a sophisticated integration module, and a number of special-purpose modules. M68HC16 devices

can be placed in low-power stop mode to minimize power consumption during periods of inactivity. The M68HC16 family provides the flexibility and features of the M68300 family, and also provides a convenient way for users of M68HC11 devices to move up to 16-bit performance.

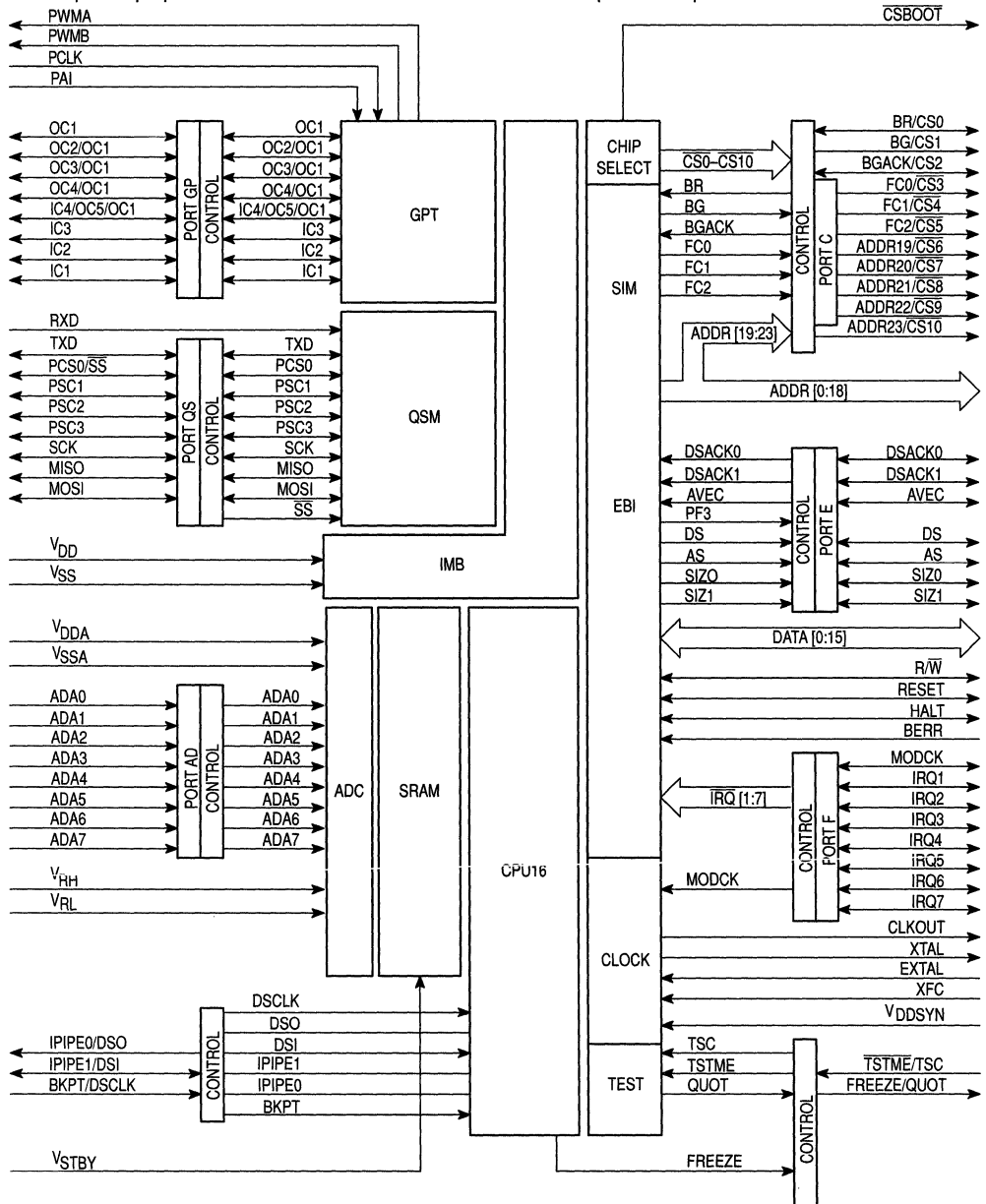


Figure 4. MC68HC16Z1 Block Diagram

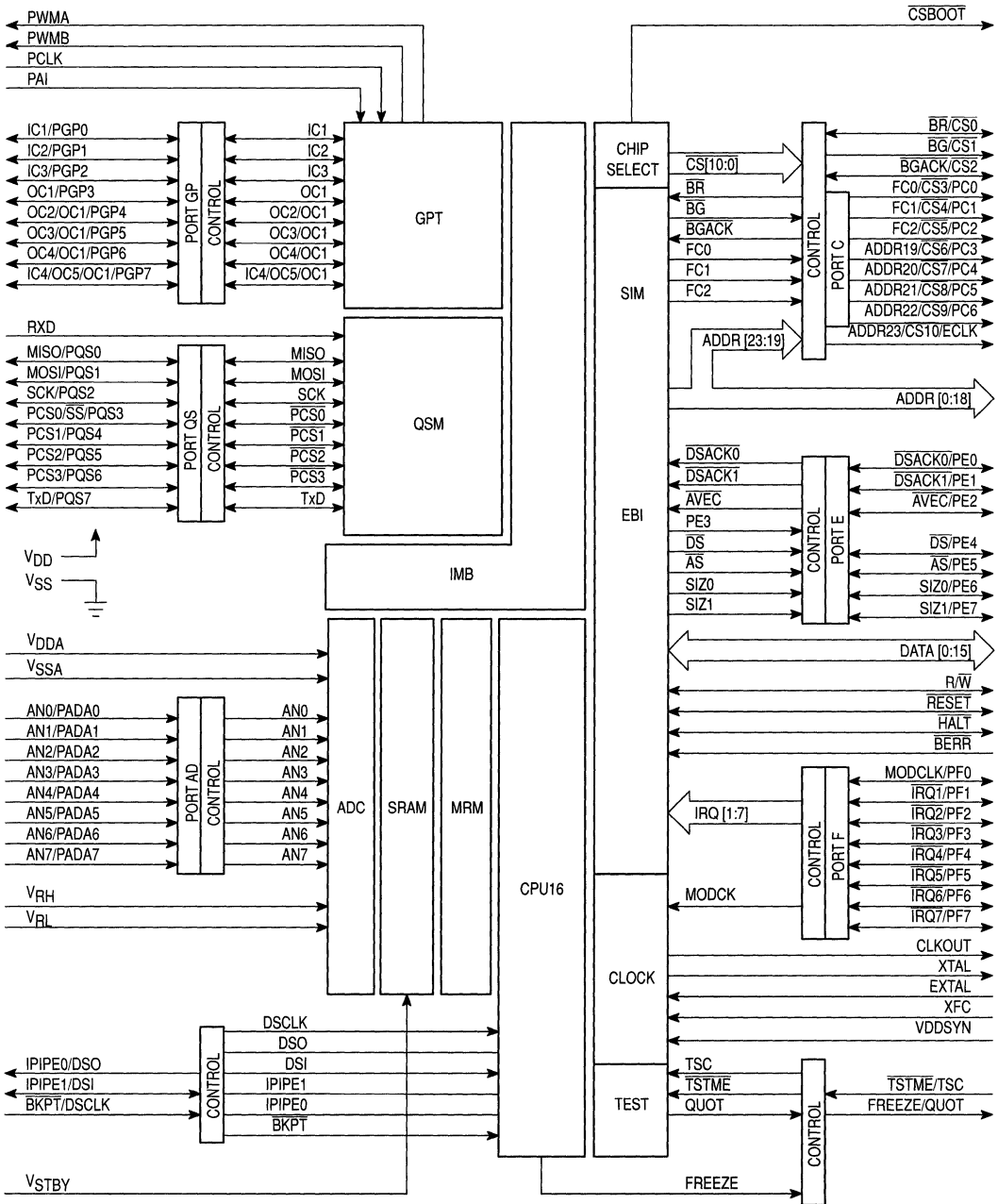


Figure 5. MC68HC16Z2 Block Diagram

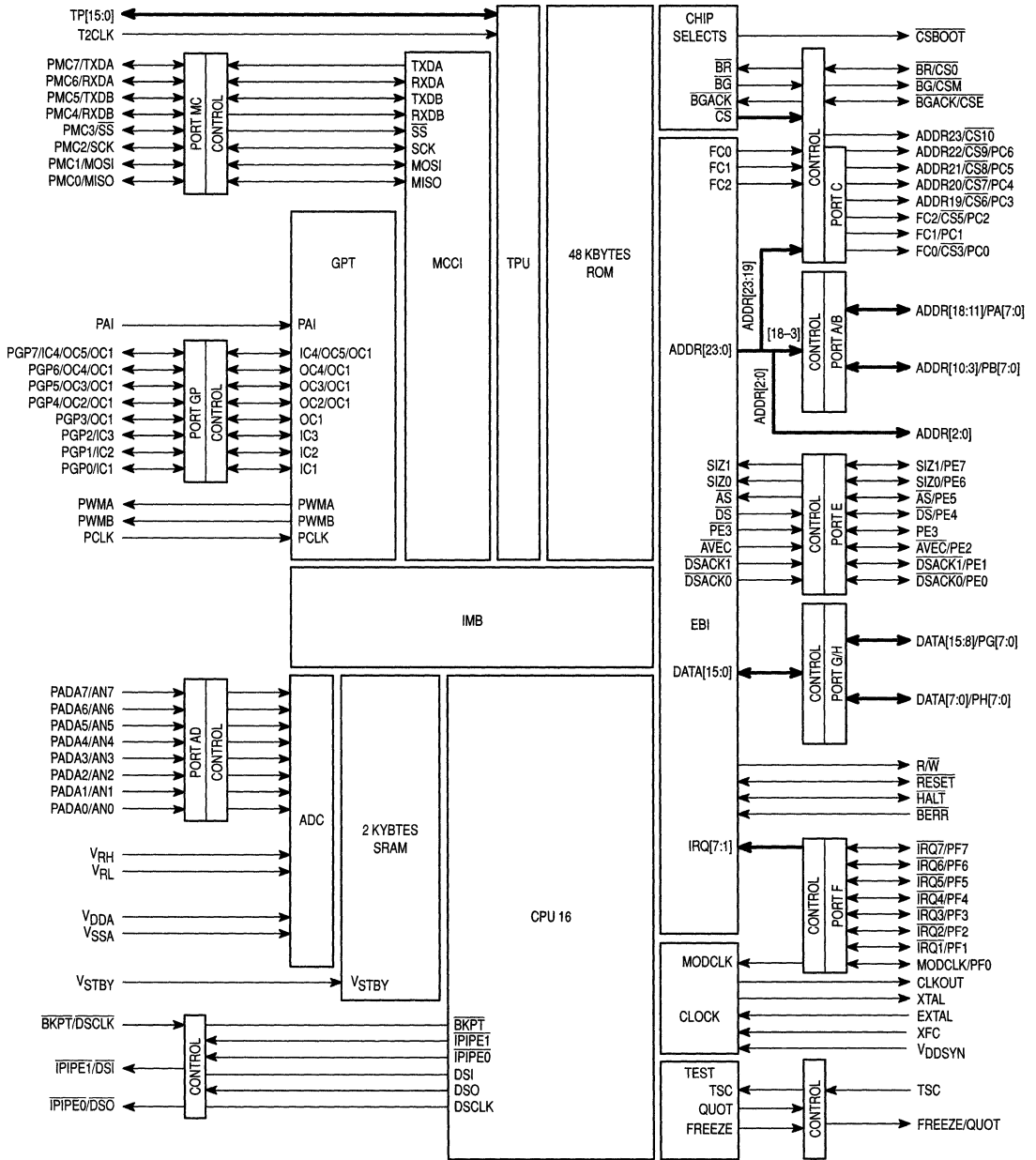


Figure 6. MC68HC16Y1 Block Diagram

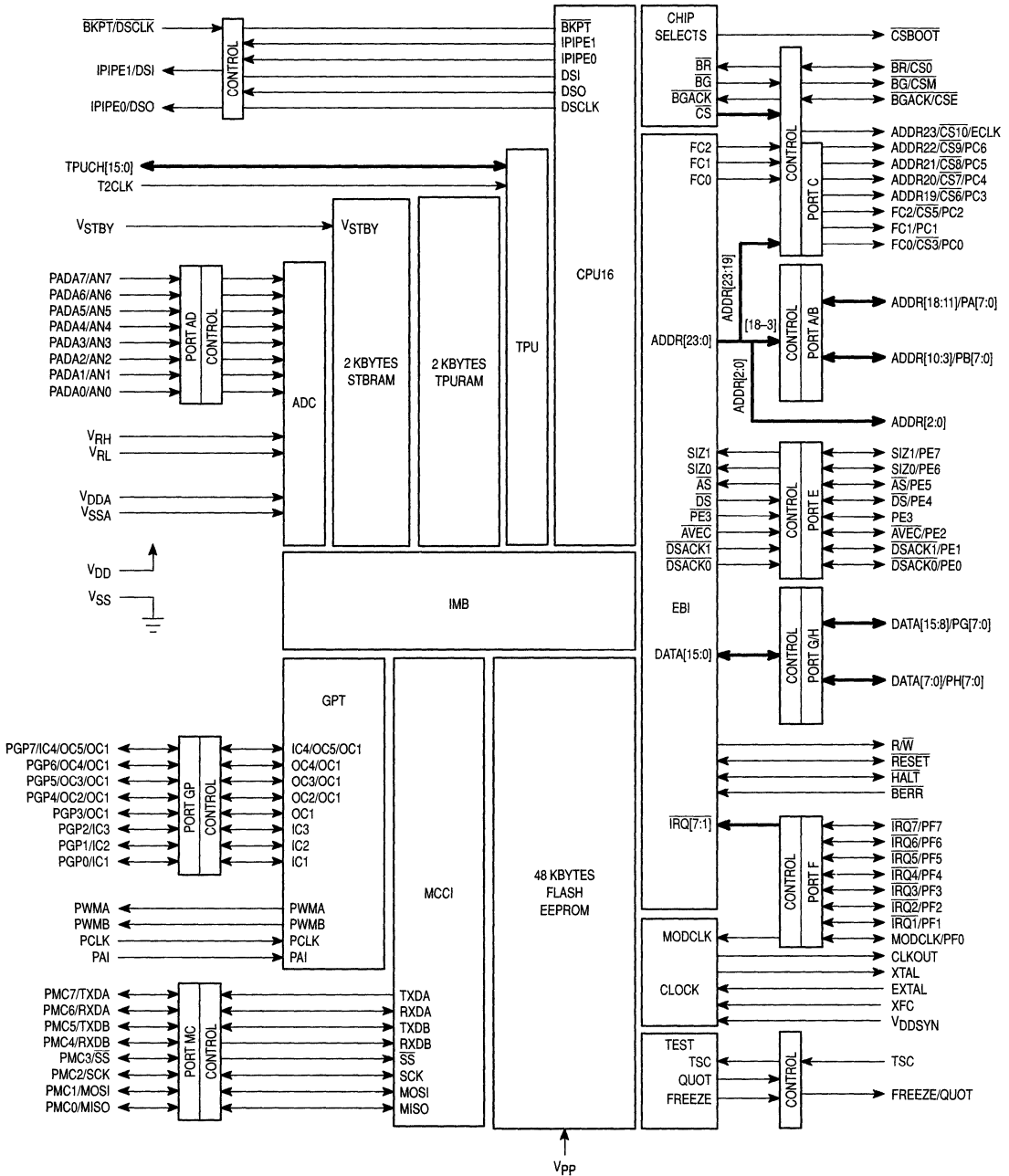


Figure 7. MC68HC916Y1 Block Diagram

**Table 7. M68HC16 Family Modular Microcontrollers**

Part Number	ROM	SRAM	EEPROM	Timer	I/O	Serial	ADC	Integration Module	Package	Comments
MC68HC16Z1	–	1K	–	GPT	46	QSM	8 Ch, 10–Bit	SIM	132–FC 132–FD 144–FM 144–FV	20 Address Lines, 12 Chip Selects, Synthesized Clock
MC68HC16Z2	8K	2K	–	GPT	46	QSM	8 Ch, 10–Bit	SIM	132–FC 132–FD	20 Address Lines, 12 Chip Selects, Synthesized Clock
MC68HC16Y1	48K	2K	–	TPU + GPT	95	MCCI	8 Ch, 10–Bit	SCIM	160–FT 160–FM	20 Address Lines, 9 Chip Selects, Single Chip or Expanded Mode
XC68HC916X1		1K	2K BEFlash 48K Flash	GPT	70	QSM	8 Ch, 10–Bit	RPSCIM	120–TH	20 Address Lines, 5 Chip Selects, Single Chip or Expanded Mode
XC68HC916Y1	–	4K	48K Flash	TPU + GPT	95	MCCI	8 Ch, 10–Bit	SCIM	160–FT 160–FM	20 Address Lines, 9 Chip Selects, Single Chip or Expanded Mode

# The M68300 Family

The high-performance M68300 family is designed for embedded control applications. Each M68300 MCU incorporates a 32-bit M68000-based CPU module (CPU32), a sophisticated integration module, and a number of dedicated special-purpose modules. In addition to utilizing a bus protocol similar to that of the M68020, the system integration module generates external bus-control signals for

M6800 devices, and provides a variety of programmable chip-select functions. M68300 devices can be placed in low-power stop mode to minimize power consumption during periods of inactivity. The M68300 family provides great design flexibility, performance, and compatibility with existing hardware and software.

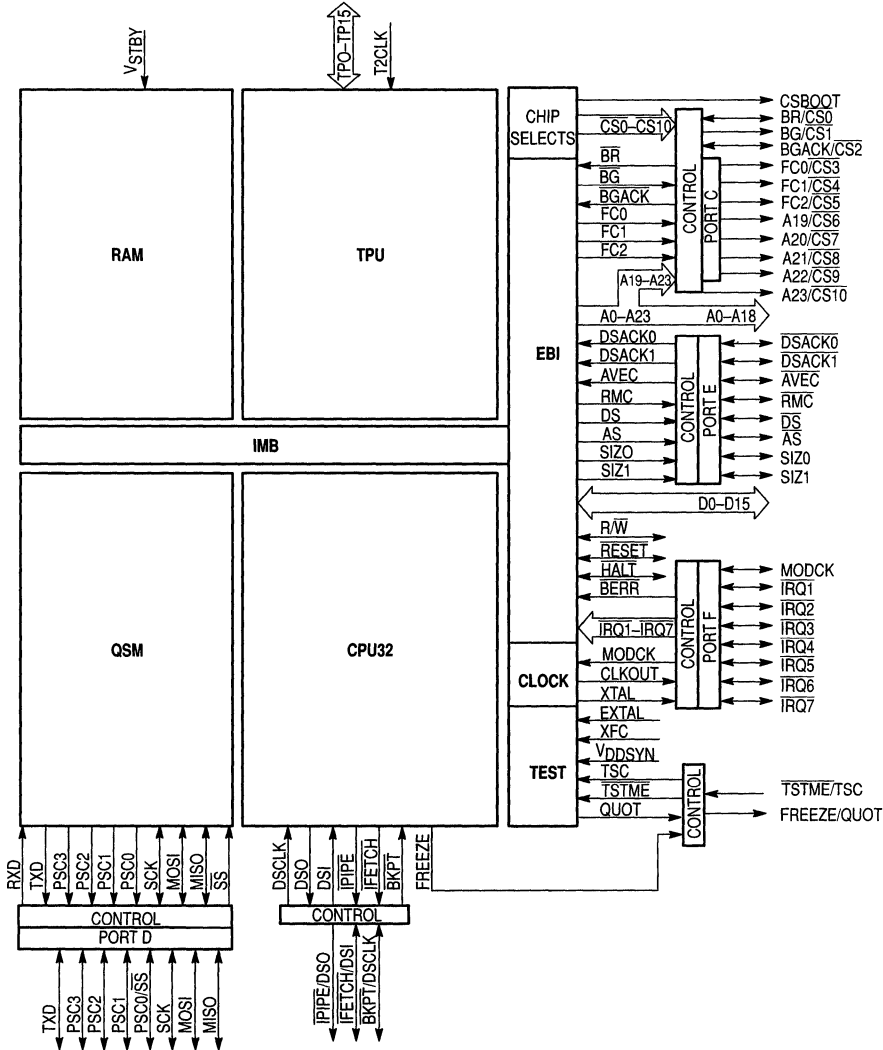


Figure 8. MC68332 Block Diagram

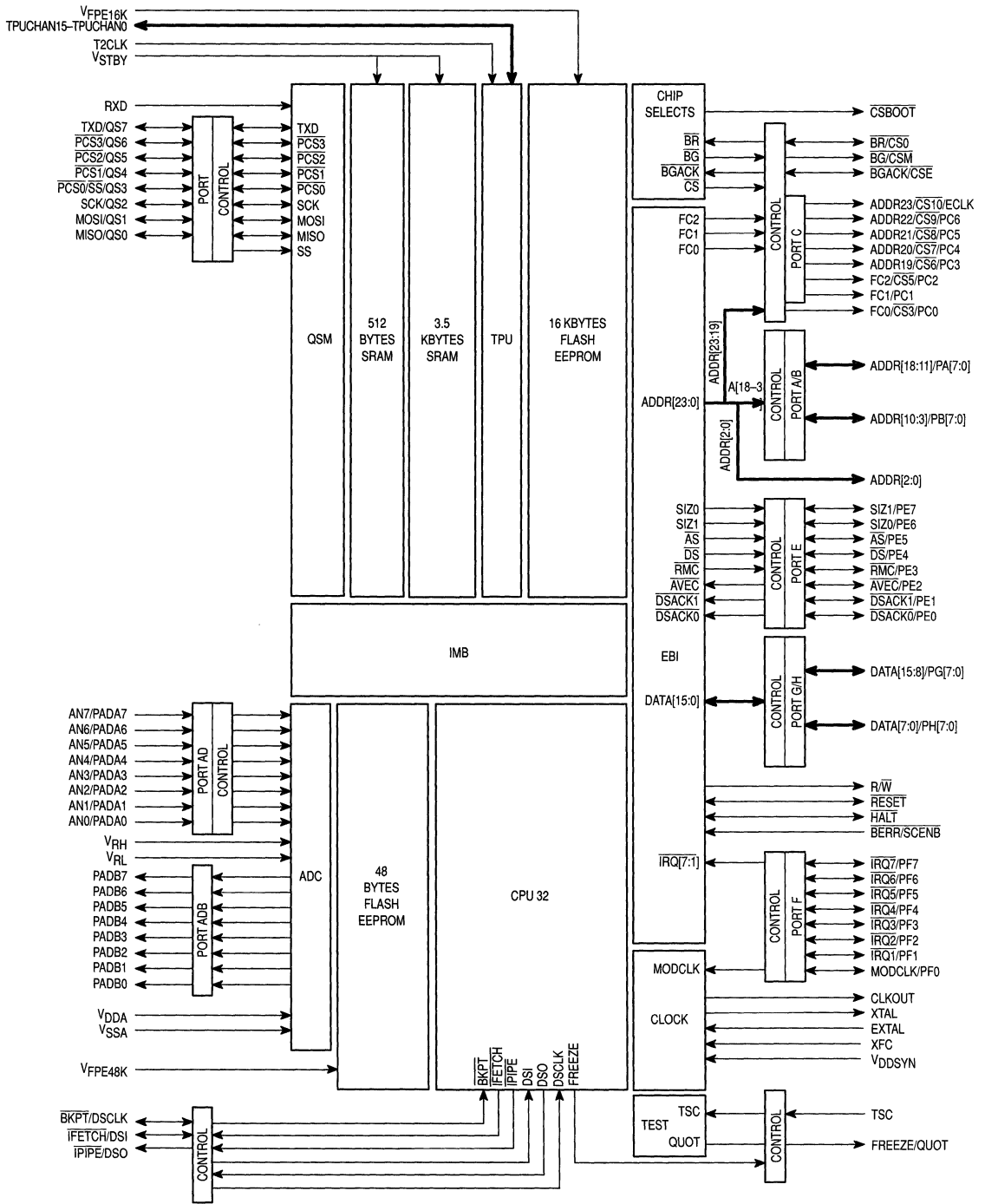


Figure 9. MC68F333 Block Diagram



**Table 8. M68300 Family Modular Microcontrollers**

Part Number	ROM	SRAM	EEPROM	Timer	I/O	Serial	ADC	Integration Module	Package	Comments
MC68331	-	-	-	GPT	43	QSM	-	SIM	132-FC, 132-FD 144-FM, 144-FV	12 Chip Selects, Synthesized Clock
MC68332	-	2K	-	TPU	47	QSM	-	SIM	132-FC, 132-FD 144-FM, 144-FV	12 Chip Selects, Synthesized Clock
PC68F333	-	4K	16K Flash, 48K Flash Emulator	TPU	96	QSM	8 Ch, 10-Bit	SCIM	160-FT, 160-FM	9 Chip Selects, Synthesized Clock
XC68334	-	1K	-	TPU	47	-	8 Ch, 10-Bit	SIM	132-FC, 132-FD	12 Chip Selects, Synthesized Clock, Single Chip or Expanded Mode

**Definitions for Tables 9 and 10**

**General Definitions**

**Package Definitions**

ADC	Analog to Digital Converter Module
A/D	Analog to Digital Converter
CPU16	16 bit Central Processing Unit
CPU32	32 bit Central Processing Unit
D/A	Digital to Analog Converter
DMA	Direct Memory Access
GPT	General-Purpose Timer
IC	Input Capture
IIC	Inter-Integrated Circuit
MCCI	Multi-Channel Communication Interface
PLL	Phase Lock Loop
OC	Output Capture
POQ	Preferred Order Quantity Multiple
PWM	Pulse Width Modulation
QSM	Queued Serial Module
RPSCIM	Reduced Pin Count SCIM
RTC	Real-Time Clock
RTI	Real-Time Interrupt
SCI	Serial Communication Interface
SCIM	Single Chip Integration Module
SIM	System Integration Module
SPI	Serial Peripheral Interface
TPU	Time Processing Unit
UART	Universal Asynchronous Receiver/Transmitter
WDOG	Watch Dog Timer

FB	10x10 mm Quad Flat Pack (QFP)
FC	Fine Pitch Plastic Quad Flat Pack (PQFP)
FD	Plastic Quad Flat Pack in Molded Carrier Ring
FE	Ceramic Quad Flat Pack (CQFP)
FM	Molded Carrier Flat Pack (CQFP)
FN	Plastic Leaded Chip Carrier (PLCC)
FS	Windowed Cerquad (Ceramic LCC)
FT	28x28 mm Quad Flat Pack (QFP)
FU	14x14 mm Quad Flat Pack (QFP)
FV	20x20 mm Quad Flat Pack (QFP)
L	Ceramic
P	Dual-in-Line Plastic
PB	Thin Quad Flat Pack (TQFP) 10x10 mm
PU	Thin Quad Flat Pack (TQFP) 14x14 mm
PV	Thin Quad Flat Pack (TQFP) 20x20mm
S	Cerdip (windowed or non-windowed)
TH	16x16 mm Quad Flat Pack (QFP)

# Microcontroller Development Tools

## M68HC05 Family

The M68HC05 Family is supported by a variety of development tools including Evaluation Modules (EVM) and Evaluation Systems (EVS). Both provide an economical means of designing, debugging, and evaluating M68HC05 microcontrollers in a target system environment.

Many new M68HC05 CSIC devices are supported by an MCU-specific EVS. The EVS is a two-board system consisting of a 68HC05 Platform Board (PFB) and an Emulator Module (EM) which contains the emulating microcontroller, and control circuits.

The M68HC05 Family is also supported by the Compact Development System (CDS) for 8-bit microcontrollers (M68CDS8HC05), a powerful, portable, full-featured emulator for debugging hardware and software operations. The CDS8HC05 features high-speed, non-invasive, in-circuit emulation with real-time trace, and a powerful bus state analyzer. Commands are entered from an MS-DOS® host computer.

The Motorola Modular Development System for the M68HC05 Family, MMDS05, allows the use of Emulation Modules (EM) that are compatible with the existing EVS product line. The MMDS05 provides an upgrade for CDS8HC05 customers. The MMDS05 has all of the features of the CDS8HC05, and includes a notable enhancement. A dual-port RAM “memory window” allows a user to modify memory while a program is running at full speed. An internal power supply and totally shielded enclosure assure compliance with FCC and EC92 regulations. The development software provided with the MMDS05 is an enhancement of the EVM05/EVM11 front end—it provides an integrated development environment with true Source Level Debug (SLD).

## M68HC11 Family

The M68HC11 Family is supported by a variety of economical development tools. These include Evaluation Boards (EVB), Evaluation Modules (EVM), and Evaluation Systems (EVS).

An EVB allows a user to debug code under the BUFFALO (Bit User Fast Friendly Aid to Logical Operations) monitor/debugging program contained in the microcontroller ROM. The EVB emulates only the single-chip mode of operation and has no EPROM programmer. The EVBU, a “universal” version of the EVB, includes a wire-wrap area for custom interfacing.

EVM are low-cost tools for designing, debugging, and evaluating M68HC11 devices in a target system. An EVM provides essential microcontroller signals and timing, and on-board monitor/debugging firmware contains extensive commands for controlling I/O and debug operations.

An EVS is a two-board system consisting of a 68HC11 Platform Board (PFB) and an Emulator Module (EM). The EM contains control circuits and a 68HC11 MCU for the part or series of parts being emulated. An EVS provides expanded, multiplexed, special test, and single-chip mode emulation, a dual 64 kbyte memory map with 64 kbytes of emulation RAM, and an RS-232 port.

In addition, the Intermetrics Whitesmiths 68HC11 C Compiler/Assembler (M68S11CCAB) and 68HC11 Simulator Debugger (M68S11SIMAB) are now available through Motorola.

## Modular Microcontroller Families

In-circuit debuggers for modular microcontroller families (M68ICD32 and M68ICD16) are economical development and debugging environments. ICD make use of the non-intrusive Background Debug Mode (BDM) interface, and provide sophisticated software debugging functions. The ICD consist of debugger and assembler development software, a small interconnect board, and target system cable. The IAS32 and IAS16 assemblers provide a single development environment that includes an editor and cross-assembler programs. ICD source-level debugger software uses easy-to-read screen windows to display register information for the CPU, the instruction pointer, breakpoints, program memory, and data memory.

The MC68331 and MC68332 are supported by evaluation kits (EVK). These multi-board systems include a common platform board, a Business Card Computer (BCC) that contains the MCU being emulated, and the CPU32BUG debug monitor program. The EVK is a cost-effective system for designing, debugging, and evaluating target system software and hardware. The MC68340 is supported by an evaluation system (EVS) similar to the EVK with the addition of a development interface board for a comprehensive development environment.

The M68HC16Z1 Evaluation Board (EVB) is an inexpensive tool for designing, debugging, and evaluating the MC68HC16Z1. Features include background-mode operation, an integrated assembly/editing/emulation environment, and logic analyzer pod connectors.

Modular evaluation boards (MEVB) for each modular family member are under development. The MEVB system is a multi-board evaluation system that consists of a common platform board (PFB) and interchangeable MCU personality boards (MPB). The MEVB system provides an economical development environment for downloading and debugging software generated with IAS16 and IAS32.

Motorola also sells the Intermetrics Whitesmiths 68HC16 C Compiler/Assembler (M68S16CCAB) and 68HC16 Simulator Debugger (M68S16SIMAB) for the M68HC16 Family. In addition, the Intermetrics InterTools™ 683XX C Compiler/Assembler (M68S32CCAB) and 683XX ROM Monitor Debugger (M68S32ROMAB) for the M68300 Family are now available through Motorola.

**Table 9. Development Tools**

Devices	Evaluation Modules*	Programmer Boards	Evaluation Systems/Kits
<b>M6800 Development Tools</b>			
MC6801		M68701EVM	
MC6801U4		M68701EVM	
MC68701		M68701EVM	
MC68701U4		M68701EVM	
MC6803		M68701EVM	
MC6803U4		M68701EVM	
<b>M68HC05 Development Tools</b>			
MC68HC05B4/B6/B8/B16 MC68HC705B5 MC68HC705B16	M68HC05X16EVS M68HC05X16EVS M68HC05X16EVS	M68HC05BPGMR M68HC05BPGMR	52PLCCU: 52 Pin PLCC Target Cable  Use M68HC05X16PGMR for 64 QFP
MC68HC05C5 XC68HC705C5	M68HC05C5EVS M68HC05C5EVS		44 PLCC05M: 44 Pin PLCC Target Cable
MC68HC05C4/C4A/C8/C9/C12 XC68HC05C4 MC68HC705C8 XC68HC705C	M68HC05C9EVS  M68HC05C9EVS	  M68HC05PGMR-2	44 PLCC05M: 44 Pin PLCC Target Cable
MC68HC05D9/D24 XC68HC05D32 MC68HC705D9	 M68HC05D32EVS M68HC05D32EVS	  M68HC05PGMR-2	44 PLCC05M: 44 Pin PLCC Target Cable
MC68HC05E1 MC68HC705E1	M68HC05E1EVS M68HC05E1EVS		
XC68HC05F2 XC68HC05F6	M68HC05F6EVM		42 SDIP Target Cable Included
XC68HC05F8 XC68HC705F8	M68HC05F8EVM M68HC05F8EVM	M68HC705F8PGMR	
MC68HC05G1 MC68HC705G1	M68HC05G1EVM M68HC05G1EVM	M68HC705G1PGMR	
XC68HC05G9 XC68HC705G9	M68HC05G9EVM M68HC05G9EVM	M68HC705G9PGMR	
XC68HC05G10 XC68HC705G10	M68HC05G10EVM M68HC05G10EVM		
XC68HC05H2	M68HC05H2EVS		
XC68HC05I8 XC68HC705I8	M68HC05I8EVS M68HC05I8EVS	M68HC705L4PGMR	
MC68HC05J1 MC68HC705J2	M68HC05P8EVS M68HC05P8EVS	M68HC705J2PGMR	
XC68HC05J3 XC68HC705J3	M68HC05J3EVS M68HC05J3EVS	M68HC705J2PGMR	
XC68HC05K0/K1 XC68HC705K1		M68HC705KIGANG** Use M68HC705KICS	M68HC705KICS In-Circuit Simulator M68HC705KICS In-Circuit Simulator

\* EVSs and EVMs include an Integrated Development Environment (IDE) which contains an editor, assembler and hardware debugger.

\* EVSs and EVMs do not include target cables or OTP/EPROM programming capability unless noted in comment section.

\*\* Development tools that are scheduled for availability during 1Q94.

**Table 9. Development Tools (continued)**

Devices	Evaluation Modules*	Programmer Boards	Evaluation Systems/Kits
<b>M68HC05 Development Tools (continued)</b>			
XC68HC05L1 XC68HC705L1	M68HC05L1EVM M68HC05L1EVM		56 SDIP Target Cable Included
XC68HC05L2 XC68HC705L2	M68HC05L2EVS M68HC05L2EVS	M68HC705L2PGMR	
XC68HC05L4 XC68HC705L4	M68HC05L4EVS M68HC05L4EVS	M68HC705L4PGMR	M68SDIP64: 64 Pin SDIP Target Cable
MC68HC05L5 MC68HC705L5	M68HC05L5EVS M68HC05L5EVS	M68HC705L5PGMR	80QFPUKIT: 80 Pin QFP Target Cable
MC68HC05L7/L9	M68HC05L9EVM2		
MC68HC05L10	M68HC05L10EVM		
XC68HC05L11	M68HC05L11EVM		
XC68HC05M4	M68HC05M4EVM		
XC68HC05P3	M68HC05P3EVS		
MC68HC05P1/P4/P6/P7/P9 XC68HC705P9	M68HC05P9EVS M68HC05P9EVS	M68HC705P9PGMR	XMDS05 Hi-Performance In-Circuit Emulator 68HC705P6 is required for P6 EVS Capability
MC68HC05P8	M68HC05P8EVS		
XC68HC05SC11/SC21/SC24/SC27	M68HC05SCEVS		ISO Adaptor Included with M68HC05SCEVS
MC68HC05T1 XC68HC05T2/T3	M68HC05T2EVS		
XC68HC05T4	M68HC05T4EVM		
MC68HC05T7/T10 XC68HC705T10	M68HC05T7EVM M68HC05T7EVM	M68HC705T10PGMR	
XC68HC05T12 XC68HC705T12	M68HC05T12EVM M68HC05T12EVM	M68HC705T12PGMR	
XC68HC05X4 XC68HC705X4	M68HC05X4EVS M68HC05X4EVS	M68HC705X4PGMR	
XC68HC05X16 MC68HC705X16	M68HC05X16EVS M68HC05X16EVS	M68HC705X16PGMR	68 PLCCU: 68 Pin PLCC Target Cable
<b>M68HC11 Development Tools</b>			
MC68HC11A0/A1/A8	M68HC11EVB M68HC11EVB2 M68HC11EVB2	M68HC11EVM	
MC68HC11D0/D3		M68HC11EVM	M68HC11D3EVS
MC68HC711D3	M68HC711D3EVB	M68HC11EVM	M68HC11D3EVS
MC68HC11E0/E1/E2/E9	M68HC11EVB M68HC11EVB2	M68HC11EVM	
MC68HC711E9	M68HC11EVB2	M68HC11EVM	
MC68HC811A8/E2	M68HC11EVB M68HC11EVB2	M68HC11EVM	

\* EVSs and EVMs include an Integrated Development Environment (IDE) which contains an editor, assembler and hardware debugger.

\* EVSs and EVMs do not include target cables or OTP/EPROM programming capability unless noted in comment section.

\*\* Development tools that are scheduled for availability during 1Q94.

**Table 9. Development Tools (continued)**

Devices	Evaluation Modules*	Programmer Boards	Evaluation Systems/Kits
<b>M68HC11 Development Tools (continued)</b>			
MC68HC11F1			M68HC11F1EVS
MC68HC11G5/G7 MC68HC711G5			M68HC11G7EVS
MC68HC11KA4			M68HC11KA4EVS
MC68HC11K0/K1/K4 MC68HC711K4			M68HC11K4EVS
MC68HC11L0/L1/L6 MC68HC711L6			M68HC11L6EVS
MC68HC11M2 MC68HC711M2			M68HC11KMNPEVS
MC68HC11N4 MC68HC711N4			M68HC11KMNPEVS
MC68HC11P2 MC68HC711P2			M68HC11KMNPEVS
<b>M68HC16 Development Tools</b>			
MC68HC16Y1	MG8MEVB16Y1		
MC68HC16Z1	M68MEVB16Z1		
MC68HC16Z2	M68MEVB16Z1		
<b>M68300 Development Tools</b>			
MC68331	M68MEVB333		M68331EVK
MC68332	M68MEVB16Z1		M68332EVS/M68332EVK
MC68F333 MC6805R2/R3	M68MEVB333		

\* EVSs and EVMs include an Integrated Development Environment (IDE) which contains an editor, assembler and hardware debugger.

\* EVSs and EVMs do not include target cables or OTP/EPROM programming capability unless noted in comment section.

\*\* Development tools that are scheduled for availability during 1Q94.

# Fuzzy Logic

Fuzzy logic replaces conventional programming techniques with a simpler approach to control algorithms. Fuzzy logic uses a series of case statements to create sophisticated features that do not require additional memory or excessive processing time.

Motorola's portfolio of fuzzy logic products is geared for every level of user. The fuzzy logic educational kit (part number FLEDKT00) includes everything needed to learn how to use fuzzy logic with M68HC05 and M68HC11 microcontrollers.

- An easy-to-follow PC-based tutorial
  - Explains fuzzy logic fundamentals, basic concepts and terminology
  - Methodology section teaches a five-step sequence of principles and procedures for designing a fuzzy logic system. These include defining the control system, writing rules and membership functions, tuning and debugging and optimizing the design.
  - Advanced topics section covers areas such as stability, adaptability, ambiguity, noise, alpha-cuts and contribution weights
- A Knowledge Base Generator (KBG)
  - Uses natural language inputs to generate a knowledge base (rules and membership functions)
  - Inference Engines for the M68HC11 and M68HC05 families implement the fuzzy logic in software ready to embed in your Motorola microcontroller application

- Runs a software simulation of the inference engine and displays a two-dimensional plot of the control surface
- Generates real-time code for the standard M68HC05 or M68HC11 microcontroller families which can be downloaded to an evaluation module (EVM) for in-circuit emulation
- Demonstration-version of Apronix's Fuzzy Inference Development Environment (FIDE) software
  - Features powerful, time-saving debug functions to help determine the correct membership functions and rules for any application
  - Demonstrates easy-to-use graphical interface for designing and debugging integrated systems

Apronix's Fuzzy Inference Development Environment (FIDE™) is a powerful software tool that allows users to easily edit, simulate, debug, and tune the membership functions and rules of a fuzzy logic application. FIDE offers graphical and natural language editing of source files. The user-friendly debug tools allow time domain simulations, three-dimensional surface displays of input-to-output relationships, and linkage of fuzzy and non-fuzzy modules. FIDE also generates assembler code that implements fuzzy logic on Motorola microcontrollers.

## On-Line Help

### Microcontroller Electronic Bulletin Board

Freeware Data Service provides a direct line to the latest information and software for Motorola microcontrollers. The Freeware bulletin board provides access to:

- Development Software for PC and Macintosh Computers
  - Cross Assemblers
  - Small C Compiler for 68HC11
  - EVM and EVB Monitor/Debugger Object Code
- Development software
  - Floating Point Routines
  - Fast Fourier Transform Routines
  - 16-Bit Math Packages
  - Utility Programs
  - User Group Library Routines and User-Donated Programs
  - Kermit File Transfer Program
  - Terminal Emulation Program
- Masked ROM information
- MCU literature listings
- Updates/Erratas to existing literature

- Press releases and updates concerning new and phase-out products
- Contests, promotions and seminars
- Electronic mail service

## How to Access Freeware

You can access Freeware from anywhere in the world. To log on, you'll need the following equipment:

1. 2400/1200/300 baud modem
2. Terminal, MS-DOS personal computer or Macintosh computer
3. Telephone line

This equipment will allow the user to read files and post questions. However, with a file transfer program such as XMODEM, YMODEM or Kermit, all information can be downloaded to your terminal or PC.

To log on:

1. Dial (512) 891-FREE (891-3733). Be sure to set the character format to 8 data, no parity, 1 stop bit.
2. Follow directions from the system.
3. Read log-on messages, then follow the directions on the screen display. A log-on session is limited to 120 minutes.

# Third-Party Support

Development support for Motorola microcontrollers is available from a variety of independent suppliers.

## Third-Party Development Tools

**Table 10. Software Products**

M68HC05 Family	M68HC11 Family	M68HC16 Family	M68300 Family
<b>Simulators</b>			
Byte Craft Ltd. P&E Microcomputer Systems, Inc. PseudoCorp. TECi	Avocet Systems, Inc. Nohau Corp. P&E Microcomputer Systems, Inc.	P&E Microcomputer Systems, Inc.	Software Environments Ltd.
<b>Assemblers</b>			
2500AD Software, Inc. American Arium Byte Craft Ltd. Computer Systems Consultants, Inc. Eris Systems, Inc. Introl Corp. Lloyd I/O, Inc. LOGISOFT Micro Dialects, Inc. Onset Computer Corp. P&E Microcomputer Systems, Inc. PseudoCorp. TECi	2500AD Software, Inc. Archimedes Software, Inc. Avocet Systems, Inc. Computer Systems Consultants, Inc. Eris Systems, Inc. Introl Corp. Lloyd I/O, Inc. LOGISOFT Micro Dialects, Inc.	2500AD Software, Inc. Byte Craft Ltd. Eris Systems, Inc. Introl Corp. Micro Dialects, Inc. P&E Microcomputer Systems, Inc.	Avocet Systems, Inc. Eyring Systems Software Division Introl Corp. Micro Dialects, Inc. Microtec Research, Inc. Oasys, Inc.
<b>Symbolic Debuggers</b>			
2500AD Software, Inc. Byte Craft Ltd. P&E Microcomputer Systems, Inc. TECi Wytec Company	2500AD Software, Inc. Microtec Research, Inc. P&E Microcomputer Systems, Inc. TECi	Byte Craft Ltd.	Eyring Systems Software Division Integrated Systems, Inc. JMI Software Consultants, Inc.
<b>Compilers</b>			
American Arium Byte Craft Ltd.	2500AD Software, Inc. Archimedes Software, Inc. Avocet Systems, Inc. Forth, Inc. Intermetrics Microsystems Software, Inc. Introl Corp. Laboratory Microsystems Inc. New Micros, Inc. Software Environments Ltd. SYNGEN Industrial Control	Byte Craft Ltd. Intermetrics Microsystems Software, Inc. Introl Corp. Software Environments Ltd.	Eyring Systems Software Division Forth, Inc. Integrated Systems, Inc. Intermetrics Microsystems Software, Inc. Introl Corp. Laboratory Microsystems Inc. Microtec Research, Inc. Microware Systems Corp. RAVEN Computer Systems Sierra Systems

**Table 10. Software Products (continued)**

M68HC05 Family	M68HC11 Family	M68HC16 Family	M68300 Family
<b>Source Level Debuggers</b>			
Byte Craft Ltd.  Yokogawa Digital Computer Corp.         Introl Corp.	Huntsville Microsystems, Inc.  Intermetrics Microsystems Software, Inc.  Introl Corp.  Yokogawa Digital Computer Corp.	Huntsville Microsystems, Inc.  Intermetrics Microsystems Software, Inc.  Introl Corp.  Yokogawa Digital Computer Corp.	Embedded Support Tools Corp.  Eyring Systems Software Division  GreenSpring Computers, Inc.  Huntsville Microsystems, Inc.  Integrated Systems, Inc.  Intermetrics Microsystems Software, Inc.   Microtec Research, Inc.  Sierra Systems  Yokogawa Digital Computer Corp.
<b>Real-Time Executives</b>			
	Accelerated Technology, Inc.  A. T. Barrett & Associates  U S Software Corporation	A. T. Barrett & Associates  U S Software Corporation	Accelerated Technology, Inc.  A. T. Barrett & Associates  Eyring Systems Software Division  GreenSpring Computers, Inc.  Integrated Systems, Inc.  JMI Software Consultants, Inc.  Microware Systems Corp.  Ready Systems  U S Software Corporation
<b>Other</b>			
PsuedoCorp	Logic Automation Inc.  LOGISOFT  PsuedoCorp  U S Software Corporation	Momentum Data Systems, Inc.  U S Software Corporation	Avocet Systems, Inc.  CARDtools Systems Corp.  Eyring Systems Software Division  GreenSpring Computers, Inc.  Integrated Systems, Inc.  JMI Software Consultants, Inc.  Logic Automation Inc.  Microware Systems Corp.  U S Software Corporation



**Table 11. Hardware Products**

M68HC05 Family	M68HC11 Family	M68HC16 Family	M68300 Family
<b>Logic Analyzers</b>			
	American Arium Hewlett-Packard Step Engineering Tektronix, Inc.	Hewlett-Packard Tektronix, Inc.	Hewlett-Packard
<b>Emulators</b>			
American Arium Orion Instruments, Inc. Pentica Systems Inc. Sophia Systems & Technology TECi Thorson Engineering Co. Trace Technology Ltd. Yokogawa Digital Computer Corp.	Advance Electronic Diagnostics, Inc. American Arium Huntsville Microsystems, Inc. MetaLink Corp. Nohau Corp. Orion Instruments, Inc. Pentica Systems Inc. Sophia Systems & Technology TECi Thorson Engineering Co. Wytec Company Yokogawa Digital Computer Corp.	Embedded Support Tools Corp. Huntsville Microsystems, Inc. Nohau Corp. Pentica Systems, Inc. Yokogawa Digital Computer Corp.	Advance Electronic Diagnostics, Inc. Applied Microsystems Embedded Support Tools Corp. Hewlett-Packard Huntsville Microsystems, Inc. Microtek International Nohau Corp. Pentica Systems Inc. Yokogawa Digital Computer Corp.
<b>Evaluation Boards</b>			
Elan Digital Systems	Elan Digital Systems Mosaic Industries, Inc. New Micros, Inc.	New Micros, Inc.	GreenSpring Computers, Inc. New Micros, Inc.
<b>Other</b>			
3M Electronic Products Division AMP Inc. EE Tools Co. Elan Digital Systems Pentica Systems Inc. TECi	3M Electronic Products Division AMP Inc. Elan Digital Systems Emulation Technology, Inc. Pentica Systems Inc. SYNGEN Industrial Control	AMP Inc. P&E Microcomputer Systems, Inc.	Emulation Technology, Inc Pentica Systems Inc.

**Table 12. Contact List**

<b>Company</b>	<b>Phone</b>
3M Electronic Products Division	(512) 984-3441
2500AD Software, Inc.	(719) 395-8683
A. T. Barrett & Associates	(713) 728-9688
Accelerated Technology, Inc.	(205) 450-0707
Advance Electronic Diagnostics, Inc.	(602) 861-9359
American Arium	(714) 731-1661
AMP Inc.	(800) 52AMP52
Applied Microsystems	(800) 426-3925
Archimedes Software, Inc.	(415) 567-4010
Avocet Systems, Inc.	(800) 448-8500
Byte Craft Ltd.	(519) 888-6911
CARDtools Systems Corp.	(408) 559-4240
Computer Systems Consultants, Inc	(404) 483-4570
EE Tools Co.	(716) 346-6973
Elan Digital Systems	(4489) 579799
Embedded Support Tools Corp.	(617) 828-5588
Emulation Technology, Inc.	(408) 982-0660
Eris Systems, Inc.	(612) 374-2967
Eyring Systems Software Division	(801) 375-2434
Forth, Inc.	(213) 372-8493
GreenSpring Computers, Inc.	(415) 327-1200
Hewlett-Packard	(800) 447-3282
Huntsville Microsystems, Inc.	(205) 881-6005
Integrated Systems, Inc.	(408) 980-1500
Intermetrics Microsystems Software, Inc.	(617) 661-0072
Introl Corp.	(414) 327-7171
JMI Software Consultants, Inc.	(215) 628-0840
Laboratory Microsystems Inc.	(310) 306-7412
Lloyd I/O, Inc.	(503) 222-0702
Logic Automation Inc.	(503) 690-6900
LOGISOFT	(408) 773-8465
MetaLink Corp.	(602) 926-0797
Micro Dialects, Inc.	(513) 271-9100
Microtec Research, Inc.	(408) 980-1300
Microtek International	(503) 645-7333
Microware Systems Corp.	(515) 224-1929
Momentum Data Systems, Inc.	(714) 577-6894
Mosaic Industries, Inc.	(415) 790-1255
New Micros, Inc.	(214) 339-2204
Nohau Corp.	(408) 866-1820
Oasys, Inc.	(617) 862-2002

**Table 12. Contact List (continued)**

<b>Company</b>	<b>Phone</b>
Onset Computer Corp.	(508) 563-9000
Orion Instruments, Inc.	(800) 729-7700
P&E Microcomputer Systems, Inc.	(617) 944-7585
Pentica Systems Inc.	(617) 275-4419
PseudoCorp.	(804) 873-1947
RAVEN Computer Systems	(612) 636-0365
Ready Systems	(800) 228-1249
Sierra Systems	(510) 339-8200
Software Environments Ltd.	(714) 588-9685
Sophia Systems & Technology	(800) 824-9294
Step Engineering	(408) 733-7837
SYNGEN Industrial Control	(403) 986-1203
TECi	(802) 525-3458
Tektronix, Inc.	(503) 629-1773
Thorson Engineering Co.	(206) 334-4214
Trace Technology Ltd.	0234 266 455
U S Software Corporation	(503) 641-8446
Wytec Company	(708) 894-1440
Yokogawa Digital Computer Corp.	(415) 570-7050



# LONWORKS™ NEURON IC Products

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## In Brief . . .

Motorola's NEURON® CHIP processors are sophisticated VLSI devices that make it possible to implement low-cost Local Operating Network applications. The unique combination of hardware and firmware provides all the key functions necessary to process inputs from sensors and control devices intelligently, and propagate control information across a variety of network media.

Used in conjunction with the LONBUILDER™ Developer's Workbench or the NODEBUILDER™ Development Tool, the NEURON CHIPS make available to a system designer an object-oriented, high-level environment providing for the easy implementation of distributed sense and control networks, flexible reconfiguration capability after network installation, and management of LONTALK™ protocol messages on the network.

Applications include distributed sense and control systems, instrumentation, machine automation, processor control, diagnostic equipment, environmental monitoring and control, power distribution and control, production control, lighting control, building automation and control, security systems, data collection/acquisition, robotics, home automation, consumer electronics, and automotive electronics.

	<b>Page</b>
NEURON CHIPS . . . . .	2.7-2
LONWORKS Technology Overview and Architecture . . . . .	2.7-5
LONBUILDER Developer's Workbench . . . . .	2.7-6
LONWORKS Support Tools . . . . .	2.7-7
LONWORKS Literature . . . . .	2.7-9

# NEURON CHIPS

Motorola's NEURON CHIPS, the MC143120 and MC143150, are the brains behind LONWORKS technology. These VLSI devices are specifically designed for distributed systems where sensing, processing, control, and communication are paramount. With LONWORKS development tools and software, they form a complete system solution that provides easy development of Local Operating Networks.

The power of both chips lies in their three respective on-board CPUs, high-speed serial communications ports (up to 1.25 MBps), and LONTALK communications protocol which is based on the OSI reference model. The difference between the two integrated circuits lies in the type and size of memory configuration; the MC143120 is targeted for cost-sensitive designs with small application programs running in internal EEPROM; the MC143150 is for larger systems with expanded memory requirements.

## MC143120 Features

The MC143120B1DW/MC143120E2DW is a complete system-on-a-chip that integrates 10K ROM, 1K/2K RAM, and 512/2K bytes EEPROM. The ROM is used for storing LONTALK protocol, operating system, and 24 I/O models that can be accessed by the application program. An additional 10 I/O models are loaded into EEPROM if needed. Application program data is stored in RAM or the internal EEPROM. The application program and system configuration data reside in the MC143120's internal EEPROM. The MC143120 is available in a 32-pin SOG package.

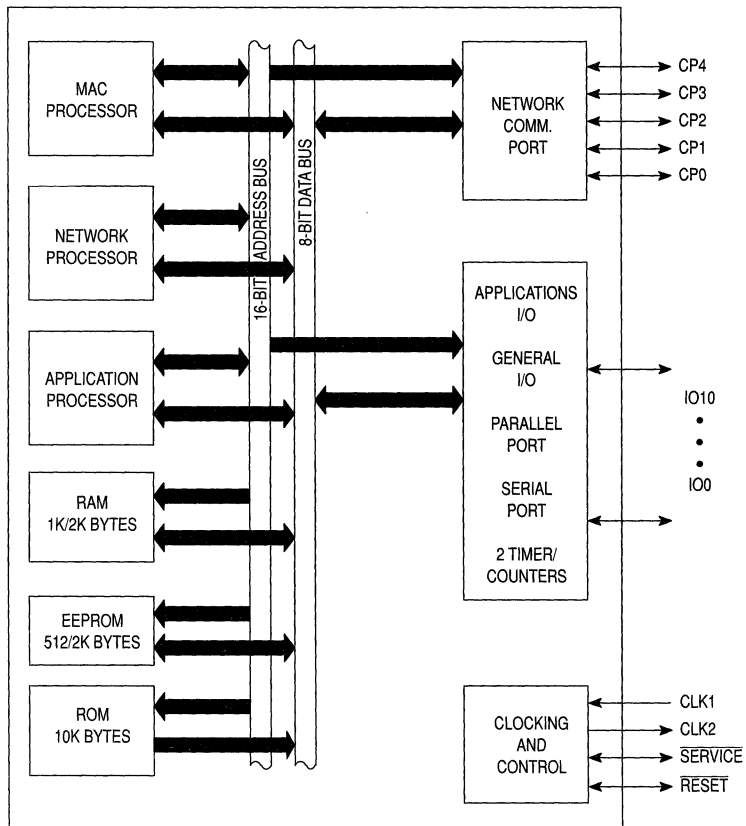


Figure 1. MC143120 (32-Lead SOG)

## NEURON CHIPS (continued)

### MC143150 Features

The MC143150 contains an additional 1K of on-chip RAM (2K total) but no on-board ROM. An external memory interface allows the system designer to use 42K of the available 64K of address space for application program storage. The remaining address space is reserved for LONTALK communications protocol, operation system, and up to 34 I/O models which are supplied with the LONBUILDER Developer's Workbench or NODEBUILDER Development Tool. The protocol and application code can be located in external ROM, EEPROM, NVRAM, or battery-backup static RAM. The MC143150 is available in a 64-pin PQFP package.

### Shared Strengths

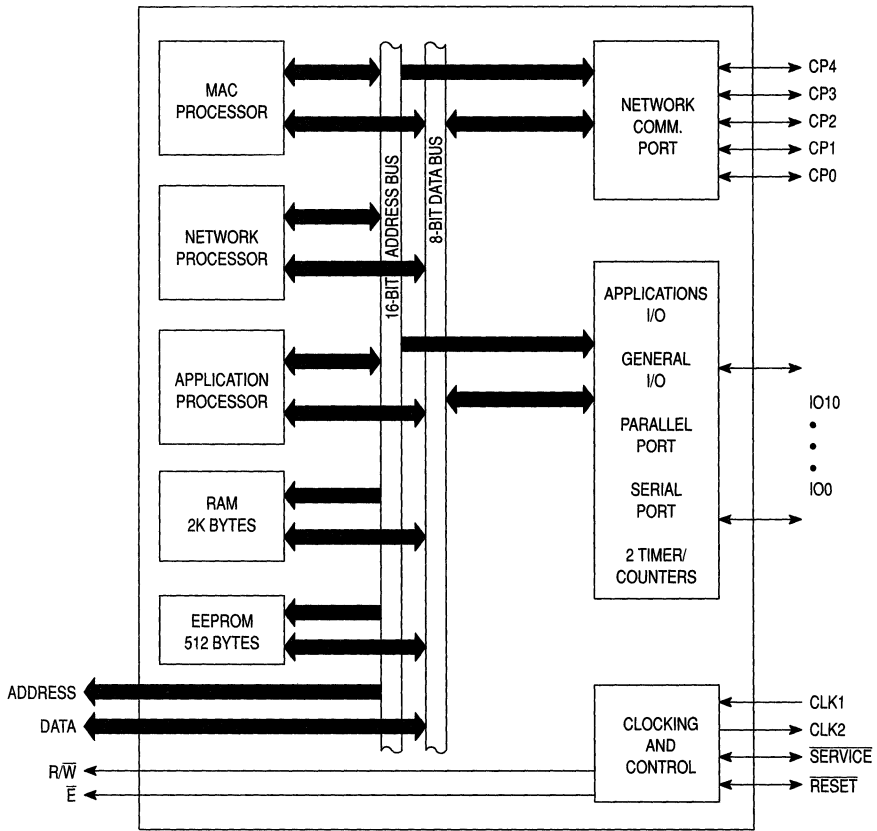
Of the three processors on-board each NEURON CHIP, two (MAC and Network processors) implement a communication subsystem, enabling the automatic transfer of information from node to node. The remaining processor handles the application program. The NEURON IC supports a maximum clock rate of 10 MHz.

Both NEURON CHIPS have eleven I/O pins (IO.0 — IO.10) to provide flexible interfacing to external hardware and access to two internal timers/counters. IO.4 — IO.7 have optional pull-up resistors. Pins IO.0 — IO.3 have high current sink capability (20 mA @ 0.8 V) while the others have a standard sink capability of 1.4 mA @ 0.4 V. All I/O pins have TTL-level inputs with hysteresis.

**Table 1. Neuron Integrated Circuits**

#### Integrated Circuits

Motorola Part No.	Description	Leads-Package	Samples	Production	Document#
MC143120DW	NEURON IC 1K RAM/512 EEPROM/10K ROM, 10 MHz, 1.2 $\mu$ m	32-SOG	Phase Out	Phase Out	BR1134/D DL159/D
MC143120B1DW	NEURON IC 1K RAM/512 EEPROM/10K ROM, 10 MHz, 0.8 $\mu$ m	32-SOG	Now	Now	
MC143150FU	NEURON IC 2K RAM/512 EEPROM, 10 MHz, 1.2 $\mu$ m	64-PQFP	Phase Out	Phase Out	
MC143150FU1	NEURON IC 2K RAM/512 EEPROM, 5 MHz, 1.2 $\mu$ m	64-PQFP	Now	Now	
MC143150B1FU	NEURON IC 2K RAM/512 EEPROM, 10 MHz, 0.8 $\mu$ m	64-PQFP	Phase Out	Phase Out	
MC143150B1FU1	NEURON IC 2K RAM/512 EEPROM, 10 MHz, 0.8 $\mu$ m	64-SOG	1Q95	Now	
MC143120E2DW	NEURON IC 2K RAM/2K EEPROM, 10 MHz, 0.71 $\mu$ m	32-SOG	4Q95	3Q96	



**Figure 2. MC143150 (64-Lead PQFP)**



# LONWORKS Technology Overview and Architecture

LONWORKS technology is a complete solution for implementing distributed control networks. These networks consist of nodes that communicate with one another over a variety of communications media using LONTALK protocol, a common, message-based communications protocol. In a LONWORKS application, nodes sense, monitor, count, measure time, manage switches and relays, and respond to conditions reported by other smart nodes.

LONWORKS technology includes all of the hardware and firmware functions needed to process data within nodes and to communicate information among nodes through a variety

of network physical layers. In one convenient package, designers can now access all the elements required to design, install, and support control networks. Those elements include: the MC143150 and MC143120 NEURON CHIPS, LONWORKS transceivers, the LONBUILDER Developer's Workbench, or NodeBuilder Development Tool and LONTALK protocol.

LONTALK protocol features seven layers, each optimized for control networks, and is based on the OSI reference model. LONTALK protocol is embedded within the firmware of Motorola's NEURON CHIPS and is the foundation of the LONWORKS technology networking solution.

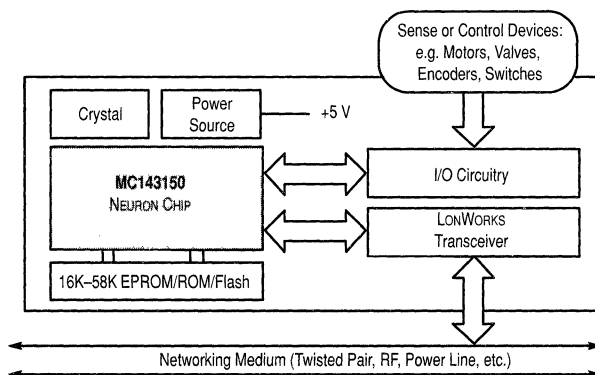


Figure 3. MC143150 in a Typical Node Block Diagram

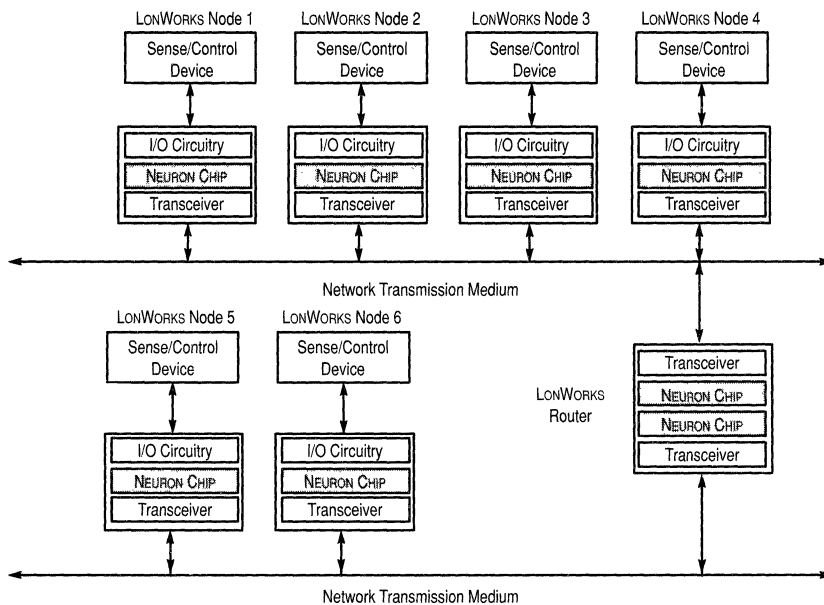


Figure 4. The MC143150 or MC143120 in a LONWORKS Network

# LONBUILDER Developer's Workbench<sup>(1)</sup>

Thanks to Echelon's LONBUILDER and NODEBUILDER tools, as well as Motorola's extensive technical support network, both system and device manufacturers can now develop control networks quickly and inexpensively. These tools provide developers with everything needed to begin building LONWORKS-based products immediately. The NODEBUILDER Development Tool is used to design individual LONWORKS products while the LONBUILDER Developer's Workbench features the tools required to develop systems consisting of multiple LONWORKS nodes. Best of all, technical support for LONWORKS technology is available worldwide through Motorola's 30 LONWORKS design centers.

LONBUILDER Developer's Workbench combines three development tools — a multi-node development system, a network manager, and a protocol analyzer — into an integrated hardware and software development environment. This development system provides the tools to create software applications and prototype hardware on a network ranging from two to hundreds of nodes. The network manager

installs and configures nodes during development, making them easy to connect, define, and build. The protocol analyzer monitors the network and interprets its activity.

The LONBUILDER Developer's Workbench includes a PC interface cards, two LONWORKS transceivers, an expandable development station with two NEURON CHIP emulator cards, DOS-based software for compiling, loading, integrating and testing LONWORKS applications, and software for monitoring and controlling a LONWORKS application.

The LONWORKS NODEBUILDER Development Tool is used to design LONWORKS nodes. The NODEBUILDER tool does not include the system integration and test tools incorporated into the LONBUILDER Developer's Workbench, but does include all the tools required to compile, load, and test code for a LONWORKS node. NODEBUILDER includes Windows-based software, a PC interface card, a prototype LONWORKS node, and two LONWORKS transceivers that are used to develop and test LONWORKS nodes.

**Table 2. LonBuilder Firmware Supported**

LonBuilder Software Version	3150 Firmware Supported	3120 Firmware Supported	3120 E1/E2 Firmware Supported	Other Firmware Supported
3.01	3-7	3, 4	6	LTM-10
3.0	3-6	3, 4	6	
2.2	2-4	2, 3, (4) <sup>1</sup>	Not Supported	
2.1	2,3	2,3	Not Supported	

Notes:

1. Version 4 support available through a patch on Echelon's Website.

**Table 3. NodeBuilder Firmware Supported**

Node Builder Software Version	3150 Firmware Supported	3120 Firmware Supported	3120 E1/E2 Firmware Supported	Other Firmware Supported
1.0	3-6	3, 4	6	LTM-10
1.5	3-6	3, 4	6	LTM-10

<sup>(1)</sup> Motorola supports these tools, but they should be purchased through Echelon Corporation (1-800-258-4566).

# LonWORKS Support Tools

Motorola's LONBUILDER support tools offer the user a quick and flexible means to demonstrate or test a LONWORKS based product which was developed and debugged on the LONBUILDER Developer's Workbench. The family of tools consist of NEURON CHIP based development boards, I/O application boards, a Differential Direct Connect Transceiver Board (for the LONBUILDER Developer's Workbench), and a

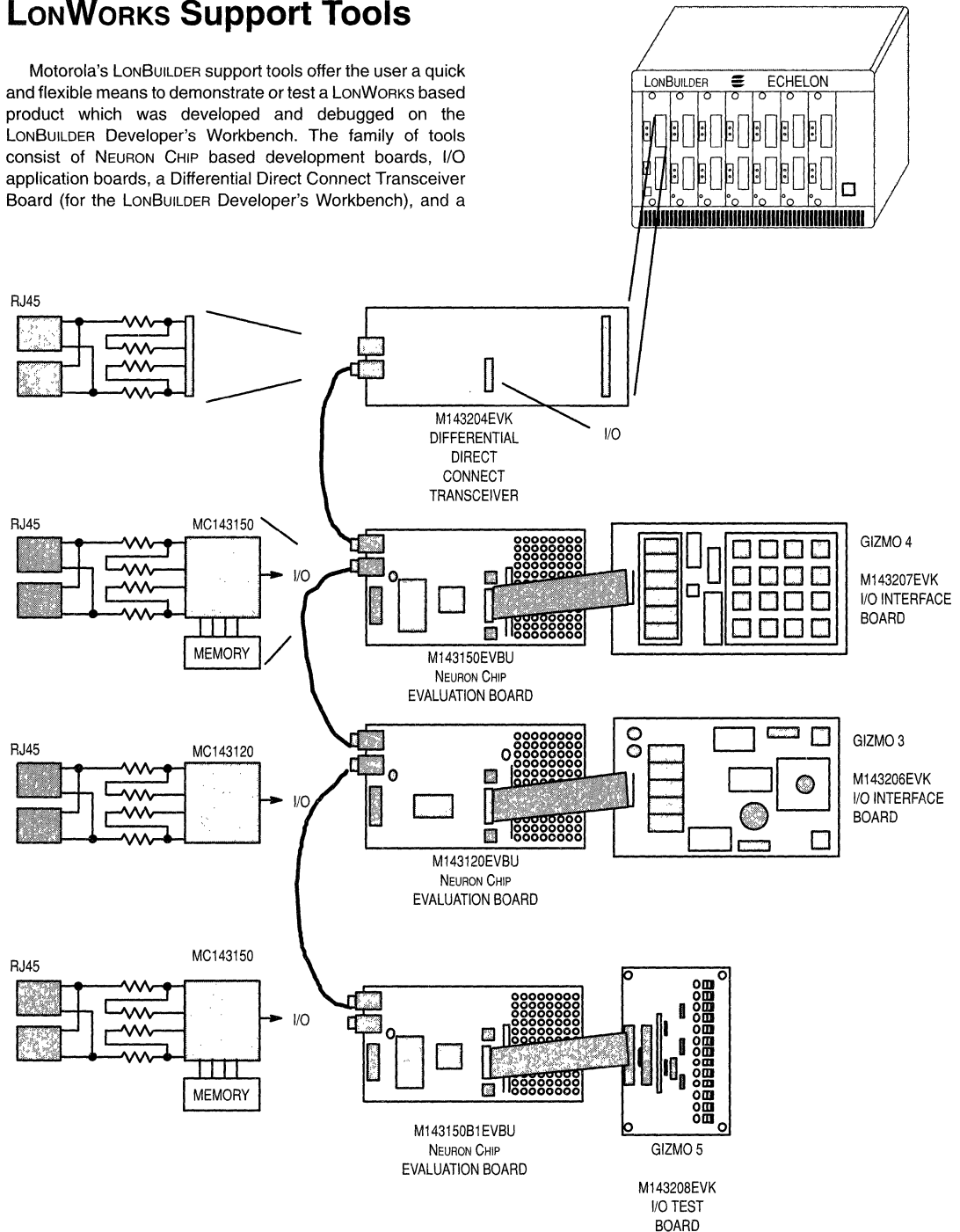


Figure 5. Evaluation and I/O Interface Boards

NEURON CHIP Test/Programming Board. The unique advantages that these tools offer are:

- The boards all have RJ45 connectors allowing ease of connectivity.
- The NEURON CHIP boards contain a 5 volt regulator allowing for a wider range of power supply voltages.
- A common 2 x 10 connector for interface to the NEURON CHIP I/O pins.

- A library of application functions are available from Motorola.
- An inexpensive means of demonstrating LONWORKS based products.

This document covers a brief detail on each of the boards. For further information, contact Motorola's LONWORKS applications support team in Austin, Texas at 512-934-8713 or FAX 512-934-7991.

### Motorola Support Tools for LONWORKS

Motorola Part No.	Description	Production	Document#
M143120EVK	143120 NEURON IC Custom Node Development Board with Socket, Supports all MC143120 NEURON Chips		BR1139
M143120B1EVBU	MC143120B1DW NEURON IC Custom Node Development Board		
M143150EVK	MC143150FU NEURON IC Custom Node Development Board		
M143150B1EVBU	MC143150B1FU NEURON IC Custom Node Development Board		
M143204EVK	Direct Connect Transceiver Board		
M143206EVK	NEURON IC I/O Interface Board (Gizmo 3)		
M143207EVK	NEURON IC I/O Interface Board (Gizmo 4)		
M143208EVK	NEURON IC I/O Interface Test Board (Gizmo 5)		
M143213EVK5	NEURON IC RF Radio with EIA-232 Interface (US Version)		
M143213EVK6	NEURON IC RF Radio with EIA-232 Interface (European Version)		
M143214EVK5	NEURON IC RF Radio with I/O Interface (US Version)		
M143214EVK6	NEURON IC RF Radio with I/O Interface (European Version)		
M143215EVK5	RF Radio for Router Interface (US Version)		
M143215EVK6	RF Radio for Router Interface (European Version)		
M143221EVK	EIA-232 EVBU Interface Board		
M143222EVK	Intelligent Neuron IC Cards (5 Cards, to be used with M143223EVK Card Reader)		
M143223EVK	NEURON IC Card Reader Board (to be used with M143222EVK Cards)		
M143226EVK	Intelligent NEURON IC Kit with UART Port		
M143232EVK	ADPCM Voice Application Kit		

# LONWORKS Literature

<b>Motorola Document No.</b>	<b>Echelon No.</b>	<b>Description</b>
DL159/D		LONWORKS Technology Device Data
BR1134/D		NEURON CHIP Product Overview
BR1139/D		LONWORKS Support Tools

Current versions (Q2/96) of the following Engineering Bulletins and Application Notes are incorporated into Motorola publication DL159/D, *LONWORKS Technology Device Data*, Revision 1.

AN781A/D		Revised Data Interface Standards
AN1208/D		Parallel I/O Interface to the NEURON CHIP
AN1211/D		Interfacing DACs and ADCs to the NEURON IC
AN1216/D		Setback Thermostat Design Using the NEURON IC
AN1225/D		Fuzzy Logic and the NEURON CHIP
AN1247/D		MC683XX to NEURON CHIP Parallel I/O Interface
AN1248/D		Interfacing the PSD3XX to the MC143150
AN1250/D		Low-Cost PC Interface to LONWORKS Based Nodes
AN1251/D		Programming the MC143120 NEURON CHIP
AN1252/D		MIP Guidelines and Design Issues
AN1266/D		LONWORKS Distributed Node Crane Demonstration
AN1276/D		Installation of Neuron Chip-Based Products
AN1278/D		LONWORKS Software Review
EB146/D	005-0003-01A	NEURON CHIP Quadrature Input Function Interface
EB147/D	005-0006-01B	LONWORKS Installation Overview
EB148/D	005-0001-01B	Enhanced Media Access Control with Echelon's LONTALK Protocol
EB149/D	005-0011-01A	Optimizing LONTALK Response Time
EB151/D	005-0004-01A	Scanning a Keypad with the NEURON CHIP
EB153/D	005-0014-01B	Driving a Seven-Segment Display with the NEURON CHIP
EB155/D	005-0019-01B	Analog-to-Digital Conversion with the NEURON CHIP
EB157/D	005-0016-01B	Creating Applications with the LONBUILDER Multi-Function I/O Kit
EB161/D	005-0017-01B	LONTALK Protocol
EB167/D	005-0043-01A	A Hybrid System for Fast Synchronized Response
EB168/D	005-0008-01C	EIA-232C Serial Interfacing with the NEURON CHIP
EB169/D	005-0032-01C	LONWORKS 78 kbps Self-Healing Ring Architecture
EB172/D	005-0024-01A	LONWORKS Custom Node Development
EB173/D	005-0027-01F	The SNVT Master List and Programmer's Guide
EB174/D	005-0023-01A	Junction Box and Wiring Guidelines for Twisted Pair LONWORKS Networks
EB176/D	005-0025-01B	File Transfer
EB177/D	005-0035-01A	LONWORKS Power Line SCADA Systems
EB178/D	005-0046-01A	Developing a Network Driver for the PC LonTalk Adapter
EB179/D	005-0060-01A	Determinism in Industrial Computer Control Networks

For the latest versions of the Echelon Engineering Bulletins listed above, download from Echelon's LonLink bulletin board.

The following documents can be ordered from Echelon Corporation.

078-0001-01A	LonBuilder User's Guide
078-0002-01	NEURON C Programmer's Guide
078-0140-01	NEURON C Reference Guide

Contact Motorola or Echelon (415-855-7400) for additional documentation.

On-Line Services	Internet Address
Motorola Microcontroller Technology Group Web Server	<a href="http://freeware.aus.sps.mot.com/MDAD/home.html">http://freeware.aus.sps.mot.com/MDAD/home.html</a> (address: 129.38.232.2)
Motorola Freeware 512-891-FREE (3733)	<a href="http://freeware.aus.sps.mot.com">http://freeware.aus.sps.mot.com</a>
Motorola FAX Request Service (MFAX) 602-244-6609	RMFAX0.email.sps.mot.com
Motorola's Design-NET	<a href="http://motserv.indirect.com">http://motserv.indirect.com</a>
Echelon's LonLink 415-856-7538	telnet lonlink.echelon.com (address: 198.93.128.100) ftp lonworks.echelon.com (address: 198.93.128.1) world wide page: <a href="http://www.lonworks.echelon.com">http://www.lonworks.echelon.com</a>

# Memory Products

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## In Brief . . .

Motorola's memory product portfolio has been expanded to support a broad range of engineering applications. Included in this portfolio are asynchronous devices with access times of 6 ns at 256K-bit density, 6 ns at 5 V 1 Megabit density, 8 ns at 3.3 V 1 Megabit density, as well as synchronous FSRAMs with access times as fast as 6 ns and 8.5 ns.

Motorola's Fast Static RAM Division goal is simple: speed. All of our SRAMs are designed to provide the highest performance, cost efficient solutions available.

The Dynamic Memory Products Division utilizes alliances as a vehicle for global customer support in the DRAM and Flash memory markets. The product portfolio consists of high-density DRAMs, standard and custom memory modules, and low power Flash memory.

	<b>Page</b>
Fast Static RAMs .....	2.8-2
Introduction .....	2.8-2
Application Specific Static RAMs .....	2.8-2
Fast Static RAM Modules .....	2.8-6
Flash Memory .....	2.8-7
Dynamic RAMs .....	2.8-7
Introduction .....	2.8-7
Dynamic RAMs (HCMOS) .....	2.8-8
DRAM Modules .....	2.8-9

# Fast Static RAMs

## Introduction

Motorola is designing the fastest, most technologically advanced fast SRAMs. From 0.8 to 0.5  $\mu\text{m}$  with access times as fast as 5 V 6 ns 256K, 6 ns 1M, 13 ns 4M, and 8 ns 3.3 V 1M; these devices are progressively smaller, faster, and lower cost. These SRAMs are designed to provide the highest performance, cost efficient solutions available. Selected fast SRAMs are also available on 2M and 8M memory modules.

Application specific memories are designed for high-performance microprocessors that require more specialization from memory cache than is available from standard devices. Products include those for use with digital signal processors as well as a variety of popular microprocessors.



# SYNCHRONOUS

## BurstRAMs™

Description	Organization	V <sub>CC</sub>	Motorola Part Number	Pin Count	Packaging	Access Time (ns Max)	Production	Comments
4M	256K x 18	3.3 V	MCM69P819	100 119	(TQ) TQFP (ZP) PBGA	3.5/3.8/4/4.5	1Q97	For servers, switches, and workstations. Samples now.
		3.3 V	MCM69F819	100 119	(TQ) TQFP (ZP) PBGA	7.5/8/8.5	1Q97	For servers, switches, and workstations. Samples now.
	128K x 36	3.3 V	MCM69P737	100 119	(TQ) TQFP (ZP) PBGA	3.5/3.8/4/4.5	1Q97	For servers, switches, and workstations. Samples now.
			MCM69F737	100 119	(TQ) TQFP (ZP) PBGA	7.5/8/8.5	1Q97	For servers, switches, and workstations. Samples now.
	128K x 32	3.3 V	MCM63P733	100	(TQ) TQFP	4/4.5/5	2Q97	133 MHz pipelined BurstRAM, for servers.
2M	64K x 32	3.3 V	MCM63P631	100	(TQ) TQFP	4.5/7/8/9	1Q97	100 MHz pipelined BurstRAM, for desktop PCs and communications applications.
1M	64K x 18	3.3 V	MCM69F618A	100	(TQ) TQFP	8.5/9/10/12	Now	Flow-through BurstRAM, 3.3 V only.
			MCM69P618A	100	(TQ) TQFP	4.5/5/6/7	Now	Pipelined BurstRAM, 3.3 V only.
		5 V	MCM67B618A	52	(FN) PLCC	8.5/9/10/12	Now	Flow-through BurstRAM for Pentium™, MIPS.
			MCM67C618A	52	(FN) PLCC	5/7	Now	Pipelined BurstRAM for Pentium.
	32K x 36	3.3 V	MCM67M618A	52	(FN) PLCC	9/10/12	Now	Flow-through BurstRAM for PowerPC™.
			MCM69F536A	100	(TQ) TQFP	8.5/9/10/12	Now	Flow-through BurstRAM, 3.3 V only.
			MCM69F536B	100	(TQ) TQFP	8.5/9/10/12	Now	Flow-through BurstRAM, 5 V tolerant I/Os.
			MCM69P536A	100	(TQ) TQFP	4.5/5/6/7	Now	Pipelined BurstRAM, 3.3 V only.
			MCM69P536B	100	(TQ) TQFP	4.5/5/6/7	Now	Pipelined BurstRAM, 5 V tolerant I/Os.

## Tag RAMs

Tag RAMs	64K x 18	3.3 V	MCM69T618	100 119	(TQ) TQFP (ZP) PBGA	5/6/7	Now Now	100 MHz Data/Tag RAM. For MIPS R5000, Pentium Pro and graphics accelerators applications.
	16K x 16	3.3 V	MPC27T416	80	(TQ) TQFP	9/10/12	Now	Cache tag RAM for PowerPC. 14 tag bits, 2 status bits.
	16K x 15	3.3 V	MPC27T415	80	(TQ) TQFP	9/10/12	Now	Cache tag RAM for PowerPC. 12 tag bits, 3 status bits. Drop in replacement for IDT71216.

## CAMs

CAMs	16K x 64	3.3 V	MCM69C432	100	(TQ) TQFP	160 ns Match Time	2Q97	Content addressable memory for communication applications. 16K connections.
	4K x 64	3.3 V	MCM69C232	100	(TQ) TQFP	160 ns Match Time	1Q97	Content addressable memory for communication applications. 4K connections.

## Integrated Cache Solutions

Integrated Cache Solutions	32K x 72	3.3 V	MPC2605	357	(ZP) PBGA	75/66 MHz	2Q97	Integrated L2 cache for PowerPC processors. One component for 256KB, two for 512KB, and four for 1MB L2 cache solution. Samples 2Q97.
	32K x 36	5 V	MPC2604GA	357	(ZP) PBGA	66 MHz	Now	Integrated L2 cache for PowerPC processors. Two components for 256KB, four for 512KB L2 cache solution.

## Separate and Dual I/O Devices

4M	512K x 9	5 V	MCM67Q909	86	(ZP) PBGA	5/6	Now	General synchronous separate I/O with write pass through. 3.3 V output levels.
1M	128K x 9	5 V	MCM67Q709	86	(ZP) PBGA	5/6	Now	General synchronous separate I/O with write pass through. 3.3 V output levels.
		5 V	MCM67Q709A	86	(ZP) PBGA	5/6	Now	General synchronous separate I/O with write pass through. 3.3 V output levels. Replaces the MCM67Q709.
	256K x 4	5 V	MCM67Q804	36	400 (WJ) SOJ	5	Now	Graphics; general RISC. Register to register. Revolutionary pinout. 3.3 V output levels. Write pass through. Separate I/O.
	32K x 36	3.3 V	MCM69Q536	176	(TQ) TQFP	8/10	3Q97	Dual address, separate I/O. Samples 3Q97. NetRAM™.
			MCM69D536	176	(TQ) TQFP	8/10	3Q97	Dual address, dual I/O. Samples 3Q97. NetRAM.
	64K x 18	3.3 V	MCM69Q618	100	(TQ) TQFP	8/10	3Q97	Dual address, separate I/O. Samples 3Q97. NetRAM.
MCM69D618			100	(TQ) TQFP	8/10	3Q97	Dual address, dual I/O. Samples 3Q97. NetRAM.	
Line Buffer	8K x 8	5 V	MCM82X308	28	300 (J) SOJ	15/17	Now	Line buffer for processing digital data.
	16K x 16	5 V	MCM62990A	52	(FN) PLCC	15/20/25	Now	For telecom switches and buffers.

## SYNCHRONOUS

### Late Write RAMs

Description	Organization	V <sub>CC</sub>	Motorola Part Number	Pin Count	Packaging	Cycle Time (ns Max)	Production	Comments		
4M	256K x 18	3.3 V	MCM69R818	119	(ZP) PBGA	7/8	Now	Not recommended for new designs. Suggest MCM69R818A.		
			MCM69R819	119	(ZP) PBGA	7/8	Now	Not recommended for new designs. Suggest MCM69R819A.		
			MCM69R820	119	(ZP) PBGA	7/8	Now	Not recommended for new designs. Suggest MCM69R820A.		
			MCM69L818	119	(ZP) PBGA	8/9	Now	Not recommended for new designs. Suggest MCM69L818A.		
			MCM69L819	119	(ZP) PBGA	8/9	Now	Not recommended for new designs. Suggest MCM69L819A.		
			MCM69L820	119	(ZP) PBGA	8/9	Now	Not recommended for new designs. Suggest MCM69L820A.		
			128K x 36	MCM69R736	119	(ZP) PBGA	7/8	Now	Not recommended for new designs. Suggest MCM69R736A.	
				MCM69R737	119	(ZP) PBGA	7/8	Now	Not recommended for new designs. Suggest MCM69R737A.	
				MCM69R738	119	(ZP) PBGA	7/8	Now	Not recommended for new designs. Suggest MCM69R738A.	
				MCM69L736	119	(ZP) PBGA	8/9	Now	Not recommended for new designs. Suggest MCM69L736A.	
	MCM69L737	119		(ZP) PBGA	8/9	Now	Not recommended for new designs. Suggest MCM69L737A.			
	MCM69L738	119		(ZP) PBGA	8/9	Now	Not recommended for new designs. Suggest MCM69L738A.			
	256K x 18	MCM69R818A		119	(ZP) PBGA	5/6/7/8	1Q97	Late write interface. Register/Register. HSTL I/Os. Samples now.		
		MCM69R819A		119	(ZP) PBGA	5/6/7/8	1Q97	Late write interface. Register/Register. LVTTTL I/Os. Samples now.		
		MCM69R820A		119	(ZP) PBGA	5/6/7/8	1Q97	Late write interface. Register/Register. 2.5 V I/Os. Samples now.		
		MCM69R821A		119	(ZP) PBGA	5/5.5	1Q97	Late write interface. Register/Register. HSTL I/Os. Dual clock. Samples now.		
		MCM69L818A	119	(ZP) PBGA	6/7/8/9	1Q97	Late write interface. Register/Latch. HSTL I/Os. Samples now.			
		MCM69L819A	119	(ZP) PBGA	6/7/8/9	1Q97	Late write interface. Register/Latch LVTTTL I/Os. Samples now.			
		MCM69L820A	119	(ZP) PBGA	6/7/8/9	1Q97	Late write interface. Register/Latch 2.5 V I/Os. Samples now.			
		128K x 36	MCM69R736A	119	(ZP) PBGA	5/6/7/8	1Q97	Late write interface. Register/Register. HSTL I/Os. Samples now.		
			MCM69R737A	119	(ZP) PBGA	5/6/7/8	1Q97	Late write interface. Register/Register. LVTTTL I/Os. Samples now.		
			MCM69R738A	119	(ZP) PBGA	5/6/7/8	1Q97	Late write interface. Register/Register. 2.5 V I/Os. Samples now.		
	MCM69R739A		119	(ZP) PBGA	5/5.5	1Q97	Late write interface. Register/Register. HSTL I/Os. Dual clock. Samples now.			
	MCM69L736A		119	(ZP) PBGA	6/7/8/9	1Q97	Late write interface. Register/Latch. HSTL I/Os. Samples now.			
	MCM69L737A		119	(ZP) PBGA	6/7/8/9	1Q97	Late write interface. Register/Latch. LVTTTL I/Os. Samples now.			
	MCM69L738A		119	(ZP) PBGA	6/7/8/9	1Q97	Late write interface. Register/Latch. 2.5 V I/Os. Samples now.			
	1M		64K x 18	3.3 V	MCM69R618	119	(ZP) PBGA	5/6/7/8	1Q97	Late write interface. Register/Register. HSTL I/Os. Samples now.
					MCM69R619	119	(ZP) PBGA	5/6/7/8	1Q97	Late write interface. Register/Register. LVTTTL I/Os. Samples now.
					MCM69R620	119	(ZP) PBGA	5/6/7/8	1Q97	Late write interface. Register/Register. 2.5 V I/Os. Samples now.
		MCM69R621			119	(ZP) PBGA	5/5.5	1Q97	Late write interface. Register/Register. HSTL I/Os. Dual clock. Samples now.	
MCM69L618		119			(ZP) PBGA	6/7/8/9	1Q97	Late write interface. Register/Latch HSTL I/Os. Samples now.		
MCM69L619		119			(ZP) PBGA	6/7/8/9	1Q97	Late write interface. Register/Latch LVTTTL I/Os. Samples now.		
MCM69L620		119			(ZP) PBGA	6/7/8/9	1Q97	Late write interface. Register/Latch 2.5 V I/Os. Samples now.		
32K x 36		MCM69R536			119	(ZP) PBGA	5/6/7/8	1Q97	Late write interface. Register/Register. HSTL I/Os. Samples now.	
		MCM69R537			119	(ZP) PBGA	5/6/7/8	1Q97	Late write interface. Register/Register. LVTTTL I/Os. Samples now.	
		MCM69R538			119	(ZP) PBGA	5/6/7/8	1Q97	Late write interface. Register/Register. 2.5 V I/Os. Samples now.	
		MCM69R539	119	(ZP) PBGA	5/5.5	1Q97	Late write interface. Register/Register. HSTL I/Os. Dual clock. Samples now.			
		MCM69L536	119	(ZP) PBGA	6/7/8/9	1Q97	Late write interface. Register/Latch HSTL I/Os. Samples now.			
		MCM69L537	119	(ZP) PBGA	6/7/8/9	1Q97	Late write interface. Register/Latch LVTTTL I/Os. Samples now.			
		MCM69L538	119	(ZP) PBGA	6/7/8/9	1Q97	Late write interface. Register/Latch 2.5 V I/Os. Samples now.			

## ASYNCHRONOUS

Density	Organization	V <sub>CC</sub>	Motorola Part Number	Pin Count	Packaging Package width in mils	Access Time (ns Max)	Production	Comments		
4M	512K x 8	5 V	MCM6246	36	400 (WJ) SOJ	20/25/35	Now	Output enable. Revolutionary pinout.		
		5 V	MCM6246A	36	400 (WJ) SOJ	15/20/25/35	1Q97	Replaces MCM6246.		
		3.3 V	MCM6946	36 44	400 (WJ) SOJ TSOP	8/10/12/15	3Q97	For Telecom, Storage and Computing Applications. Samples 2Q97.		
	1M x 4	3.3 V	MCM6943	44 44	400 (YJ) SOJ TSOP	8/10/12/15	3Q97	For Telecom, Storage and Computing Applications. Samples 2Q97.		
		5 V	MCM6249	32	400 (WJ) SOJ	20/25/35	Now	Output enable. Revolutionary pinout.		
		3.3 V	MCM6249A	32	400 (WJ) SOJ	15/20/25/35	1Q97	Replaces MCM6249.		
1M	64K x 18	5 V	MCM67A618A	52	(FN) PLCC	10/12/15	Now	General asynchronous, latched address and data.		
		3.3 V	MCM6323	44	400 (YJ) SOJ	12/15	Now	Revolutionary pinout.		
	128K x 8	5 V	MCM6226B	32	300 (J), 400 (WJ) SOJ	15/17/20/25	Now	Evolutionary pinout.		
		5 V	MCM6226BB	32	300 (EJ), 400 (XJ) SOJ	15/17/20/25	Now	Evolutionary pinout.		
		5 V	MCM6726B	32	400 (WJ) SOJ	8/10/12	Now	Revolutionary pinout.		
		5 V	MCM6726C	32	400 (WJ) SOJ	6/7	Now	Not recommended for new designs. Suggest MCM6726D.		
		5 V	MCM6726D	32	400 (WJ) SOJ	7.5/8/10/12	1Q97	Revolutionary pinout.		
		3.3 V	MCM6926	32	400 (WJ) SOJ	8/10/12/15	Now	Revolutionary pinout.		
	256K x 4	3.3 V	MCM6926A	32	400 (WJ) SOJ	8/10/12/15	2Q97	Revolutionary pinout. Will replace MCM6926.		
			5 V	MCM6229B	28	300 (J), 400 (WJ) SOJ	15/17/20/25	Now	Evolutionary pinout.	
		5 V	MCM6229BB	28	300 (EJ), 400 (XJ) SOJ	15/17/20/25	Now	Evolutionary pinout.		
			MCM6729B	32	400 (WJ) SOJ	8/10/12	Now	Not recommended for new designs. Suggest MCM6729D.		
		5 V	MCM6729C	32	400 (WJ) SOJ	6/7	Now	Revolutionary pinout.		
			MCM6729D	32	400 (WJ) SOJ	7.5/8/10/12	4Q96	Revolutionary pinout. Will replace MCM6729B.		
		3.3 V	MCM6929	32	400 (WJ) SOJ	8/10/12/15	Now	Revolutionary pinout.		
			MCM6929A	32	400 (WJ) SOJ	8/10/12/15	2Q97	Revolutionary pinout. Will replace MCM6929.		
		1M x 1	5 V	MCM6227B	28	300 (J), 400 (WJ) SOJ	15/17/20/25	Now	For Telecom and IC Tester applications.	
		256K	16K x 16	5 V	MCM62996	52	(FN) PLCC	15/20/25	Now	Choice of 5 V or 3.3 V power supplies for output buffers. For wide bus applications.
				5 V	MCM62995A	52	(FN) PLCC	15/20/25	Now	DSP96000 and RISC applications. Latched address inputs.
		DSPRAM™	8K x 24	5 V	MCM56824A	52	(FN) PLCC	20/25/35	Now	Designed for DSP56001 applications. Replaces 38K x 8s.
256K	32K x 8	5 V	MCM6206BA	28	300 (EJ) SOJ	12/15/20/25	Now	Replaces MCM6206D.		
		5 V	MCM6706B	28	300 (J) SOJ	8/10	Now	Evolutionary pinout.		
		5 V	MCM6706BR	32	300 (J) SOJ	6/7/8	Now	Revolutionary pinout.		
	64K x 4	5 V	MCM6709B	28	300 (J) SOJ	8/10	Now	Evolutionary pinout.		
		5 V	MCM6709BR	28	300 (J) SOJ	6/7/8	Now	Revolutionary pinout.		

## FAST STATIC RAM MODULES

(Contact Fast Static RAM Marketing for Custom Fast SRAM Modules)

### PowerPC Processor Applications

Description	Chip Set	Functionality	Cache Size	Bus Speed (Max)	Pro-duction	Packaging	Motorola Part Number
PowerPC Cache Modules with 16K x 15 CacheTag	PowerPC CHRP Platforms	Flow-Through Burst	512KB Cache	66 MHz	Now	178 Pin Card Edge DIMM (DG)	MPC2105A
		Flow-Through Burst	1MB	66 MHz	Now		MPC2106A
PowerPC Cache Modules with 16K x 15 CacheTag	PowerPC CHRP Platforms	Pipelined Burst	256KB Cache	Up to 66 MHz	1Q97	178 Pin Card Edge DIMM (DG)	MPC2104P
		Pipelined Burst	512KB Cache	Up to 66 MHz	1Q97		MPC2105P

### Pentium Processor Applications

Description	Organization	Functionality	Cache Size	Bus Speed (Max)	Pro-duction	Packaging	Motorola Part Number
Coast Modules	32K x 64	Piped Burst 8 Bit TAG	256KB Cache	66 MHz	1Q97	160 Pin Card Edge DIMM (DG)	MCM64PE32
	64K x 64	Piped Burst 8 Bit TAG	512KB Cache	66 MHz	1Q97	160 Pin Card Edge DIMM (DG)	MCM64PE64

### Networking and Buffer Applications Asynchronous Modules

Description	Organization	Access Time (Max)	Production	Packaging	Comments	Motorola Part Number
Standard Asynchronous FSRAM Modules	1M x 32	20/25 ns	1Q97	72 Pin SIMM (SG)	Uses eight 1M x 4 SRAMs	MCM321024
	512K x 32	20/25 ns	1Q97	72 Pin SIMM (SG)	Uses four 512K x 8 SRAMs	MCM32515
	1M x 8	15 ns	1Q97	72 Pin SIMM (SG)	Uses eight 1M x 1 SRAMs	MCM8A10SG

### Networking and Buffer Applications Synchronous Modules

Description	Organization	Access Time (Max)	Production	Packaging	Comments	Motorola Part Number
Standard Synchronous FSRAM Modules	64K x 72 512KB	9/10/12 ns	Now	168 Pin DIMM (DG)	Flow-through synchronous BurstRAM	MCM72F6DG
	128K x 32 1 MB	9/10/12 ns	Now	168 Pin DIMM (DG)	Flow-through synchronous BurstRAM	MCM72F7DG
	512K x 72 2MB	8/10/12 ns	Now	168 Pin DIMM (DG)	Flow-through synchronous BurstRAM	MCM72F8DG
	1M x 72 4 MB	8/10/12 ns	Now	168 Pin DIMM (DG)	Flow-through synchronous BurstRAM	MCM72F9DG
	2M x 72 8 MB	8/10/12 ns	Now	168 Pin DIMM (DG)	Flow-through synchronous BurstRAM	MCM72F10DG
	4M x 72 16 MB	8/10/12 ns	Now	168 Pin DIMM (DG)	Flow-through synchronous BurstRAM	MCM72F11DG

## Flash Memory

Flash memory is the most cost-effective non-volatile semiconductor memory. Flash possesses a distinct advantage over traditional non-volatile memories in that it can be easily programmed while remaining in the system.

Motorola's Dynamic Memory Products Division will offer a portfolio of low power flash memory devices. Please contact your Motorola sales representative for more information.

## Dynamic RAMs

### Introduction

DRAMs offer the lowest cost per bit of any memory. Because of this, they are popular for a wide range of applications, particularly in the computing and communication environments. Motorola's Dynamic Memory Products include DRAM components and memory modules. The 16 MByte DRAM component is offered in various organizations and surface mount packaging. Motorola's DRAM memory modules include densities up to 32 MByte in both standard and custom configurations. All devices are fabricated using HCMOS technology.

## DYNAMIC RAMS (HCMOS) (Contact DRAM Marketing)

Byte Density	Organization	Motorola Part Number	Pins	Package Options	Access Time (ns Max)	Operating Current (mA Max)	Production	Volt	FPM or EDO	Refresh
4 MB	4M x 1	MCM44100C	20/26	300 SOJ(N)	60/70	110/100	NOW	5	FPM	1K
		MCM4L4100C	20/26	300 SOJ(N)	60/70	110/100	NOW	5	FPM	1K
		MCM54100A	20/26	300 SOJ(N), 300 TSOP(T)	60/70	120/100	NOW	5	FPM	1K
		MCM5L4100A	20/26	300 SOJ(N), 300 TSOP(T)	60/70	120/100	NOW	5	FPM	1K
		MCM54100A-C	20/26	300 SOJ(N), 300 TSOP(T)	70/80	100/85	NOW	5	FPM	1K
		MCM54100A-V	20/26	300 SOJ(N), 300 TSOP(T)	70/80	70/60	NOW	3.3	FPM	1K
		MCM5L4100A-V	20/26	300 SOJ(N), 300 TSOP(T)	70/80	70/60	NOW	3.3	FPM	1K
	1M x 4	MCM44400C	20/26	300 SOJ(N)	60/70	110/100	NOW	5	FPM	1K
		MCM4L4400C	20/26	300 SOJ(N)	60/70	110/100	NOW	5	FPM	1K
		MCM54400A	20/26	300 SOJ(N), 300 TSOP(T)	60/70	120/100	NOW	5	FPM	1K
		MCM5L4400A	20/26	300 SOJ(N), 300 TSOP(T)	60/70	120/100	NOW	5	FPM	1K
		MCM54400A-C	20/26	300 SOJ(N)	70/80	100/85	NOW	5	FPM	1K
		MCM5L4400A-C	20/26	300 SOJ(N), 300 TSOP(T)	70	100	NOW	5	FPM	1K
		MCM54400A-V	20/26	300 SOJ(N), 300 TSOP(T)	70/80	70/60	NOW	3.3	FPM	1K
MCM5L4400A-V	20/26	300 SOJ(N), 300 TSOP(T)	70/80	70/60	NOW	3.3	FPM	1K		
16 MB	4M x 4	MCM317400C	24/26	300 SOJ(J), 300 TSOP(T)	60/70	120/105	NOW	5	FPM	2K
		MCM417400	24/26	300 SOJ(J)	60/70	110/100	NOW	5	FPM	2K
		MCM417400B	24/26	300 SOJ(J), 300 TSOP(T)	60/70	110/100	4Q96	5	FPM	2K
		MCM417405B	24/26	300 SOJ(J), 300 TSOP(T)	60/70	110/100	4Q96	5	EDO	2K
		MCM516400B	24/26	300 SOJ(J), 300 TSOP(T)	50/60/70	100/80/70	Call Mktg	5	FPM	4K
		MCM517400B	24/26	300 SOJ(J), 300 TSOP(T)	50/60/70	130/110/95	NOW	5	FPM	2K
		MCM517400C	24/26	300 SOJ(J), 300 TSOP(T)	60/70	110/95	4Q96	5	FPM	2K
		MCM517400CV	24/26	300 SOJ(J), 300 TSOP(T)	60/70	75/65	4Q96	3.3	FPM	2K
		MCM517405C	24/26	300 SOJ(J), 300 TSOP(T)	60/70	110/95	4Q96	5	EDO	2K
		MCM517405CV	24/26	300 SOJ(J), 300 TSOP(T)	60/70	75/65	4Q96	3.3	EDO	2K
	1M x 16	MCM218160B	42	400 SOJ(J)	60/70	180/170	1Q97	5	FPM	1K
		MCM218160B	44/50	400 TSOP(T)	60/70	180/170	1Q97	5	FPM	1K
		MCM218165B	42	400 SOJ(J)	60/70	170/160	1Q97	5	EDO	1K
		MCM218165B	44/50	400 TSOP(T)	60/70	170/160	1Q97	5	EDO	1K
MCM518160B	42	400 SOJ(J)	60/70	185/155	TBD	5	FPM	1K		
MCM518160B	44/50	400 TSOP(T)	60/70	185/155	NOW	5	FPM	1K		
MCM518165B	42	400 SOJ(J)	60/70	185/155	TBD	5	EDO	1K		
MCM518165B	44/50	400 TSOP(T)	60/70	185/155	NOW	5	EDO	1K		
MCM518165BV	42	400 SOJ(J)	60/70	175/145	TBD	3.3	EDO	1K		
MCM518165BV	44/50	400 TSOP(T)	60/70	175/145	NOW	3.3	EDO	1K		

**DRAM MODULES (Contact DRAM Marketing for Custom DRAM Modules)** (See Notes 1 and 2)

Byte Density	Organization	Motorola Part Number	Pins	Package Options	Access Time	Production	Operating Current (mA Max)	Volt	FPM or EDO	(B)uffered or (U)nbuffered	Parity, Non-Parity, ECC, or ECC Pin for Parity	Refresh	Comp. Pkg.
1 MB	1M x 8	MCM81430	30	(S)	60/70	NOW	240/200	5	FPM	U	Non-Parity	1K	SOJ
4 MB	4M x 8	MCM84000	30	(AS)	60/70	NOW	960/800	5	FPM	U	Non-Parity	2K	SOJ
		MCM84C430	30	(S)	60/70	NOW	220/190	5	FPM	U	Non-Parity	2K	SOJ
		MCM84CT430	30	(S)	60/70	NOW	220/190	5	FPM	U	Non-Parity	2K	TSOP
	4M x 9	MCM94000	30	(AS)	60/70	NOW	1080/900	5	FPM	U	Parity	2K	SOJ
		MCM94C430	30	(S)	60/70	NOW	340/290	5	FPM	U	Parity	2K	SOJ
		MCM94CT430	30	(S)	60/70	NOW	340/290	5	FPM	U	Parity	2K	TSOP
	1M x 32	MCM32100	72	(DG), (D)	60/70	NOW	960/800	5	FPM	U	Non-Parity	1K	TSOP
		MA321BT08T	72	(ADG), (AD)	60/70	NOW	370/310	5	FPM	U	Non-Parity	1K	TSOP
		MB321BT08T	72	(ADG), (AD), (ASN)	60/70	NOW	370/310	5	EDO	U	Non-Parity	1K	TSOP
		MB321BT18T	72	(ADG), (ADN)	60/70	NOW	350/290	3.3	EDO	U	Non-Parity	1K	TSOP
		MCM32B116	72	(S), (SG)	60/70	TBD	370/310	5	FPM	U	Non-Parity	1K	SOJ
		MB321BJ08T	72	(ASN)	60/70	TBD	360/300	5	EDO	U	Non-Parity	1K	SOJ
		MCM32BT116	72	(SH)	60/70	NOW	370/310	5	FPM	U	Non-Parity	1K	TSOP
		MCM32130	72	(SH), (SHG)	60/70	NOW	960/800	5	FPM	U	Non-Parity	1K	SOJ
		MCM32T100	72	(SH), (SHG)	60/70	NOW	960/800	5	FPM	U	Non-Parity	1K	TSOP
8 MB	2M x 32	MA322BT08T	72	(ADG)	60/70	NOW	374/314	5	FPM	U	Non-Parity	1K	TSOP
		MB322BT08T	72	(ADG), (ASN)	60/70	NOW	374/314	5	EDO	U	Non-Parity	1K	TSOP
		MB322BT18T	72	(ADG)	60/70	NOW	352/292	3.3	EDO	U	Non-Parity	1K	TSOP
		MCM32B216	72	(S), (SG)	60/70	TBD	374/314	5	FPM	U	Non-Parity	1K	SOJ
		MB322BJ08T	72	(ASN)	60/70	TBD	374/314	5	EDO	U	Non-Parity	1K	SOJ
		MCM32BT216	72	(SH)	60/70	NOW	374/314	5	FPM	U	Non-Parity	1K	TSOP
		MCM32230	72	(SH), (SHG)	60/70	NOW	976/816	5	FPM	U	Non-Parity	1K	SOJ
		MCM32T200	72	(S), (SG)	60/70	NOW	976/816	5	FPM	U	Non-Parity	1K	TSOP
16 MB	4M x 32	MCM32C400	72	(ASH), (ASHG)	60/70	4Q96	880/760	5	FPM	U	Non-Parity	2K	SOJ
		MB324CJ00T	72	(BSN)	60/70	4Q96	880/760	5	EDO	U	Non-Parity	2K	SOJ
		MCM32CT400	72	(ASH), (ASHG)	60/70	4Q96	880/760	5	FPM	U	Non-Parity	2K	TSOP
		MCM32CT420	72	(ADG)	60/70	4Q96	880/760	5	FPM	U	Non-Parity	2K	TSOP
		MB324CT00T	72	(BDG), (BSN)	60/70	4Q96	880/760	5	EDO	U	Non-Parity	2K	TSOP
		MCM32CT423	72	(ADG)	60/70	4Q96	600/520	3.3	FPM	U	Non-Parity	2K	TSOP
		MB324CT10T	72	(BDG)	60/70	4Q96	880/760	3.3	EDO	U	Non-Parity	2K	TSOP
32 MB	8M x 32	MCM32C800	72	(ASH), (ASHG)	60/70	4Q96	896/776	5	FPM	U	Non-Parity	2K	SOJ
		MB328CJ00T	72	(BSN)	60/70	4Q96	896/776	5	EDO	U	Non-Parity	2K	SOJ
		MCM32CT800	72	(ASH), (ASHG)	60/70	4Q96	896/776	5	FPM	U	Non-Parity	2K	TSOP
		MB328CT00T	72	(BSN)	60/70	4Q96	896/776	5	EDO	U	Non-Parity	2K	TSOP
4 MB	1M x 36	MCM36104	72	(S), (SG)	60/70	NOW	1060/900	5	FPM	U	ECC for Parity	1K	SOJ
8 MB	2M x 36	MCM36204	72	(S), (SG)	60/70	NOW	1096/918	5	FPM	U	ECC for Parity	1K	SOJ

**DRAM MODULES (Contact DRAM Marketing for Custom DRAM Modules)** (See Notes 1 and 2)

Byte Density	Organization	Motorola Part Number	Pins	Package Options	Access Time	Production	Operating Current (mA Max)	Volt	FPM or EDO	(B)uffered or (U)nbuffered	Parity, Non-Parity, ECC, or ECC Pin for Parity	Refresh	Comp. Pkg.
16 MB	4M x 36	MCM36C400	72	(AS), (ASG), (ASH), (ASHG)	60/70	NOW	1360/1160	5	FPM	U	Parity	2K	SOJ
		MCM36C404	72	(ASH), (ASHG)	60/70	4Q96	990/855	5	FPM	U	ECC for Parity	2K	SOJ
32 MB	8M x 36	MCM36C800	72	(AS), (ASG)	60/70	NOW	1384/1184	5	FPM	U	Parity	2K	SOJ
		MCM36C804	72	(ASH), (ASHG)	60/70	NOW	1008/873	5	FPM	U	ECC for Parity	2K	SOJ
4 MB	1M x 40	MCM40100	72	(AS), (ASG)	60/70	NOW	200/1000	5	FPM	U	ECC	1K	SOJ
8 MB	2M x 40	MCM40200	72	(AS), (ASG)	60/70	NOW	1220/1020	5	FPM	U	ECC	1K	SOJ
16 MB	4M x 40	MCM40C400	72	(SH), (SHG)	60/70	NOW	1100/950	5	FPM	U	ECC	2K	SOJ
32 MB	8M x 40	MCM40C800	72	(SH), (SHG)	60/70	NOW	1120/970	5	FPM	U	ECC	2K	SOJ
8 MB	1M x 64	MA641AJ40T	168	(ADG)	60/70	NOW	2050/1715	5	FPM	B	Non-Parity	1K	SOJ
		MCM64BT116	168	(DG)	60/70	NOW	828/700	5	FPM	B	Non-Parity	1K	TSOP
		MB641BT48T	168	(ADG)	60/70	NOW	828/700	5	EDO	B	Non-Parity	1K	TSOP
		MA641BT08T	168	(ADG)	60/70	4Q96	740/620	5	FPM	U	Non-Parity	1K	TSOP
		MB641BT08T	168	(ADG)	60/70	4Q96	740/620	5	EDO	U	Non-Parity	1K	TSOP
		MB641BT18T	168	(ADG)	60/70	4Q96	700/580	3.3	EDO	U	Non-Parity	1K	TSOP
16 MB	2M x 64	MCM64BT216	168	(DG)	60/70	NOW	836/704	5	FPM	B	Non-Parity	1K	TSOP
		MB642BT48T	168	(ADG)	60/70	NOW	836/704	5	EDO	B	Non-Parity	1K	TSOP
		MA642BT08T	168	(ADG)	60/70	4Q96	748/628	5	FPM	U	Non-Parity	1K	TSOP
		MB642BT08T	168	(ADG)	60/70	4Q96	748/628	5	EDO	U	Non-Parity	1K	TSOP
		MB642BT18T	168	(ADG)	60/70	4Q96	708/588	3.3	EDO	U	Non-Parity	1K	TSOP
32 MB	4M x 64	MA644CT00T	168	(ADG)	60/70	4Q96	1760/1520	5	FPM	U	Non-Parity	2K	TSOP
		MB644CT00T	168	(ADG)	60/70	4Q96	1760/1520	5	EDO	U	Non-Parity	2K	TSOP
		MA644CT10T	168	(ADG)	60/70	4Q96	1200/1040	3.3	FPM	U	Non-Parity	2K	TSOP
		MB644CT10T	168	(ADG)	60/70	4Q96	1200/1040	3.3	EDO	U	Non-Parity	2K	TSOP
	1M x 72	MA721BT08T	168	(ADG)	60/70	4Q96	980/820	5	FPM	U	ECC	1K	TSOP
	2M x 72	MA722BT08T	168	(ADG)	60/70	4Q96	990/835	5	FPM	U	ECC	1K	TSOP
	4M x 72	MA724CT00T	168	(ADG)	60/70	4Q96	1980/1710	5	FPM	U	ECC	2K	TSOP
		MB724CT00T	168	(ADG)	60/70	4Q96	1980/1710	5	EDO	U	ECC	2K	TSOP
		MA724CT10T	168	(ADG)	60/70	4Q96	1350/1170	3.3	FPM	U	ECC	2K	TSOP
		MB724CT10T	168	(ADG)	60/70	4Q96	1350/1170	3.3	EDO	U	ECC	2K	TSOP
MA724CJ40T		168	(ADG)	60/70	4Q96	2060/1770	5	FPM	B	ECC	2K	SOJ	
MB724CJ40T		168	(ADG)	60/70	4Q96	2060/1770	5	EDO	B	ECC	2K	SOJ	

## NOTES:

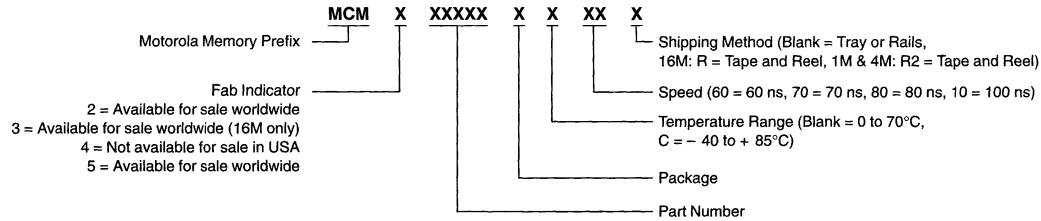
- Package suffixes are enclosed by ( ) in package column  
 AD/ADG = DIMM/Gold Pad DIMM (Board Revision)  
 AS and ASN/ASG = Tin Pad SIMM (Board Revision)/Gold Pad SIMM (Board Revision)  
 ASH/ASHG = Low Profile SIMM/Low Profile Gold Pad SIMM  
 BDG = Board Revision DIMM Gold Lead

- BSN/BSG = Board Revision SIMM Tin Lead/Board Revision SIMM Gold Lead  
 D/DG = Dual Inline Memory Module (DIMM)/Dual Inline Gold Pad Module  
 S/SG = Single Inline Memory Module/Gold Pad SIMM  
 SH/SHG = Short Height SIMM/Short Height Gold Pad SIMM
- Please consult factory before ordering a gold module package type.

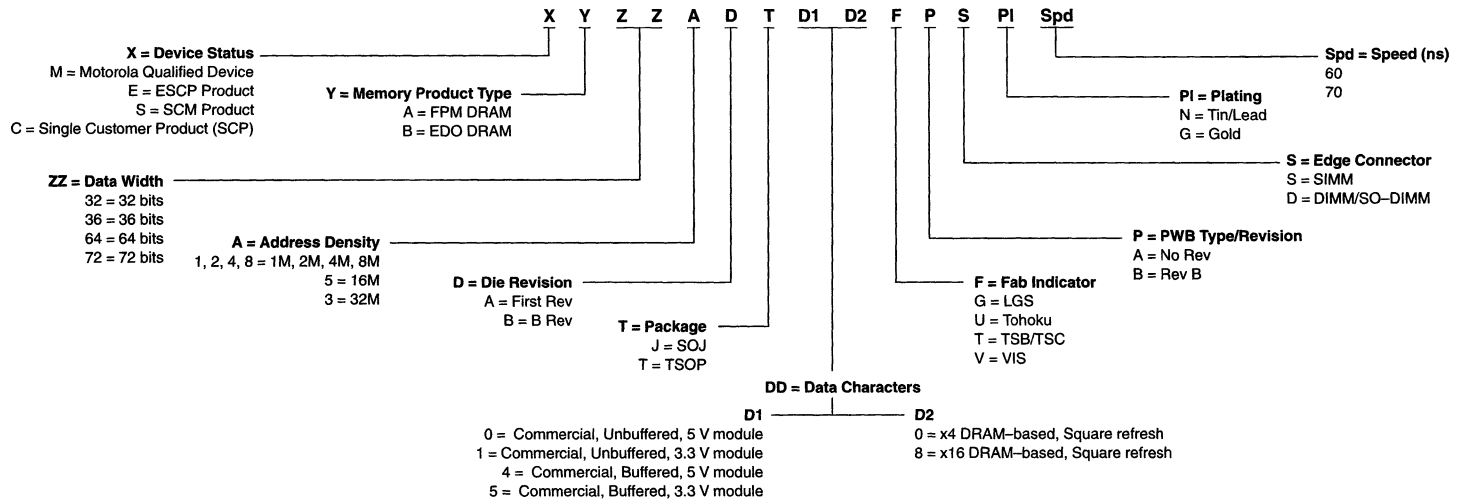


## ORDERING INFORMATION

### COMPONENT AND FIRST GENERATION MODULE PART NOMENCLATURE



### NEXT GENERATION MODULE PART NOMENCLATURE





# Logic: Standard, Special and Programmable

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## In Brief . . .

This selector guide is a quick reference to Motorola's vast offering of standard logic integrated circuits. In TTL, popular due to its ease of use, low cost, medium-to-high speed operation and good output drive capability, Motorola offers both LS and FAST. Motorola's CMOS portfolio includes MC14000B standard CMOS series devices, High-Speed CMOS consisting of a full line of products that are pinout-compatible with many LSTTL and MC14000B standard CMOS logic devices which offers designers a solution to the long-standing combined barrier — high speed and low power. Motorola's Emitter Coupled Logic (MECL) is a non-saturated form of digital logic which eliminates transistor storage time permitting very high speed operation. Motorola offers five versions of MECL: MECL 10K, MECL 10H, MECL III, and the recently introduced families ECLinPS (ECL in picoseconds) and ECLinPS Lite. Also included are timing solution products such as clock drivers, clock generators and programmable delay chips, high performance and communications products such as VCO's, prescalers, and synthesizers, and a wide variety of translators, low-voltage bus interface and serial data transmission devices. Field programmable logic and in particular, field programmable arrays, have become the solution of choice for logic design implementation in applications where time to market is a critical product development factor. In addition, reconfigurable arrays have been used to enhance Customer product flexibility in ways that no other technology can match.

A New Product Calendar is printed quarterly that reflects any recent device releases and the approximate dates new devices are expected to be released. This New Product Calendar, BR1332/D, can be ordered from your nearest Motorola Sales Office, the Motorola Literature Distribution Center, the Motorola fax response system Mfax™ (602) 244-6609, or from Motorola Semiconductor's World Wide Web site at:

<http://www.mot.com/SPS>

	<b>Page</b>
Motorola Logic Families: Which Is Best for You? . . . .	3.1-1
Motorola Programmable Arrays (MPA) . . . . .	3.1-5
Selection by Function	
Logic Functions . . . . .	3.1-12
Device Index . . . . .	3.1-40
Ordering Information . . . . .	3.1-50
Case Outlines . . . . .	3.1-54
Packaging Information . . . . .	3.1-85
Surface Mount . . . . .	3.1-85
Pin Conversion Tables . . . . .	3.1-85
Tape and Reel . . . . .	3.1-86



# Motorola Logic Families, Which Is Best for You?

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## Introduction

When a logic designer is faced with developing a new product requiring performance significantly different from the past, it might be well to examine various logic family alternatives. Selecting a logic family for a new design from today's rapidly changing semiconductor technologies can be a perilous task. With the many choices available, it is easy to under-kill or over-kill an application with inadequate or excessive capabilities.

By selecting the family whose parameters most closely fit your needs, you can save many future headaches. Obviously, before selecting a specific device, a detailed review of the vendor's data sheet specifications is recommended.

## Family Comparison

Table 1. compares some typical characteristics of several popular logic families available in the market today. The following sections provide brief explanations of the various parameters.

**Table 1. Logic Family Comparison**

Typical Commercial Parameters (0° to +70°C)	Logic Families												
	TTL/ABT				CMOS					ECL			
	LS	ALS	ABT	FAST	MG	HC	FACT	LVC	LCX	10KH	100K	ECLinPS <sup>3</sup>	E-Lite
<b>Speed</b>													
OR Gate Prop Delay (t <sub>PLH</sub> ) ns	9	7	2.7	3	25	8	5	3.3	3.5	1	0.75	0.33	0.22
D Flip-Flop Toggle Rate MHz	33	45	200	125	4	45	160	200	200	330	400	1000	2800
Output Edge Rate ns	6	3	3	2	100	4	2	3.7	3.6	1	0.70	0.50	0.25
<b>Power Consumption (Per Gate)</b>													
Quiescent mW	5	1.2	0.005	12.5	0.0006	0.003	0.003	0.0001	1E-04	25	50	25	73
Operating (1MHz) mW	5	1.2	1.0	12.5	0.04	0.6	0.8	0.6	0.3	25	50	25	73
<b>Supply Voltage</b> V	+4.5 to 5.5	+4.5 to 5.5	+4.5 to 5.5	+4.5 to 5.5	+3 to 18	+2 to 6	+2 to 6	+1.2 to 3.6	+2 to 3.6	-4.5 to -5.5	-4.2 to -4.8	-4.2 to -5.5	-4.5 to -5.5
<b>Output Drive</b> mA	8	8	32/64	20	1	4	24	24	24	50Ω Load	50Ω Load	50Ω Load	50Ω Load
<b>5V Tolerant</b>													
Inputs	N/A	N/A	N/A	N/A	N/A	N/A	N/A	YES	YES	N/A	N/A	N/A	N/A
Outputs	N/A	N/A	N/A	N/A	N/A	N/A	N/A	NO	YES	N/A	N/A	N/A	N/A
<b>DC Noise Margin<sup>1</sup></b>													
High Input %	22	22	22	22	30	30	30	30	30	28	41	28/41	33
Low Input %	10	10	10	10	30	30	30	30	30	31	31	31/31	33
<b>Packaging<sup>4</sup></b>													
DIP	YES	YES	YES	YES	YES	YES	YES	NO	NO	YES	YES	NO	NO
SO	YES	YES	YES	YES	YES	YES	YES	YES	YES	NO	NO	NO	YES
LCC	NO	YES	NO	YES	NO	NO	YES	NO	NO	YES	NO	YES	NO
SSOP	NO	YES	YES	YES	NO	YES	YES	YES	YES	NO	NO	NO	NO
TSSOP	NO	NO	NO	NO	YES	YES	YES	YES	YES	NO	NO	NO	NO
<b>Functional Device Types</b>	190	210	50	110	125	103	80	35	27 <sup>2</sup>	64	44	48	40
<b>Relative 1-25 Price/Gate</b>	0.9	1	1.6	1	0.9	0.9	1.4	1.8	1.8	2	10	25	32

### NOTES:

1. Typical noise margin expressed as a percentage of typical output voltage swing.
2. Announced plans for Motorola offering.

3. ECLinPS is Available in both 10KH and 100K compatible versions.
4. A "YES" may not include all devices within a family.

### VENDORS REFERENCED (DATA BOOK):

LS Motorola Low power Schottky TTL (DL121)  
 ALS Texas Instruments Advanced Low power Schottky TTL (SDAD001B)  
 ABT Philips Semiconductor (IC23)  
 FAST Motorola Advanced Schottky TTL (DL121)  
 MG Motorola 14000 Series Metal Gate CMOS (DL131)  
 HC Motorola High-Speed Silicon Gate CMOS (DL129)

FACT Motorola Advanced CMOS (DL138)  
 LCX Motorola Low-Voltage CMOS (BR1339)  
 LVC Philips Low-Voltage CMOS (IC24)  
 10KH Motorola 10KH Series ECL (DL122)  
 100K National 100K Series ECL (F100K)  
 ECLinPS Motorola Advanced ECL (DL140)  
 E-Lite Motorola (ECLinPS Lite) Advanced ECL (DL140)

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 FAST and FACT are trademarks of National Semiconductor Corp.

## Logic Families

Although there are many family technologies available, they can be divided into roughly three broad categories: Transistor–Transistor Logic (TTL), Complementary Metal–Oxide Semiconductor logic (CMOS), and Emitter–Coupled Logic (ECL). TTL and ECL are bipolar technologies differing in implementation techniques, while CMOS (an MOS technology) differs in fundamental transistor structure and operation.

### TTL

The designation “bipolar” essentially refers to the basic component utilized to build this family of integrated circuits, the bipolar transistor. By employing a bipolar transistor in a logic function’s output driver as well as the input buffer, it results in a Transistor–to–Transistor (TTL) direct connection. Older technologies were interconnected via passive components such as resistors or diodes.

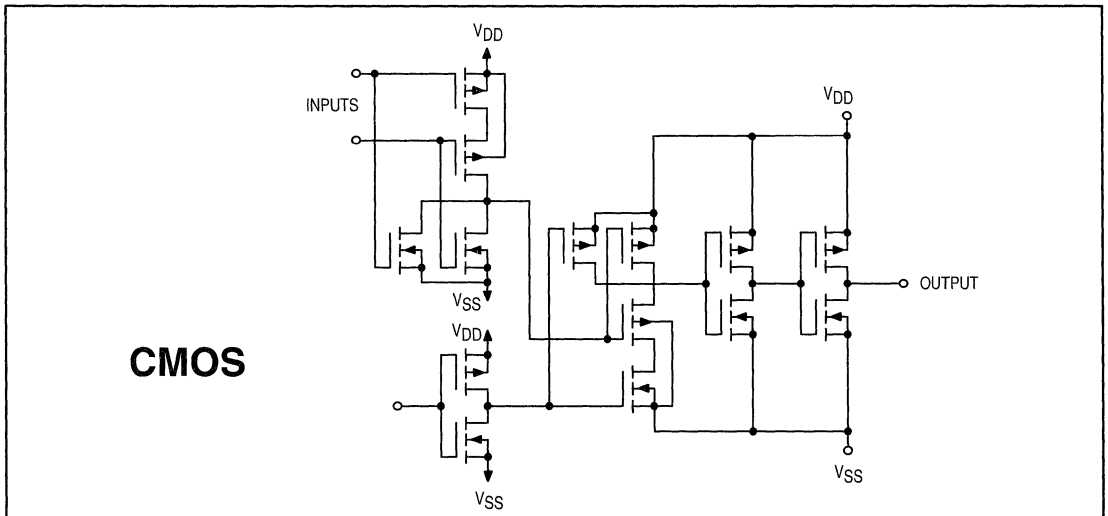
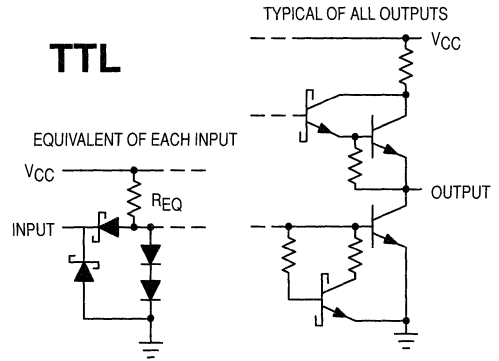
Since the original TTL design, several enhancements have been employed to reduce power and increase speed. Common to these has been the use of Schottky diodes which, ironically, no longer result in strictly TTL connections. Consequently, the two names, Schottky and TTL, are used in combination: LS (Low power Schottky), ALS (Advanced Low power Schottky), and FAST™ (Advanced Schottky) TTL.

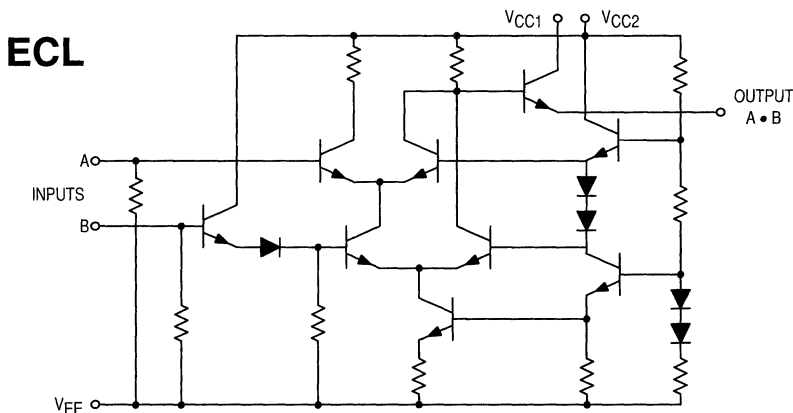
The superior characteristics of TTL compared to CMOS, in the past, have been its relatively high speed and high output drive; these advantages are rapidly diminishing as described in the next section. One family of devices, ABT (Advanced BiCMOS Technology), utilizes TTL circuitry at the inputs and outputs, and CMOS technology in between—attempting to combine the advantages of both bipolar and CMOS.

### CMOS

Complementary Metal–Oxide Semiconductor (CMOS) field–effect transistors differ from bipolar both in structure and operation. The primary advantages of CMOS are its low power dissipation and small physical geometry. Advances in design and fabrication have brought CMOS devices into the same speed and output drive capability as TTL. Again, enhancements have resulted in the evolution of additional classifications: MG (Metal–Gate CMOS), HC (High–speed silicon–gate CMOS), and FACT™ (Advanced CMOS).

The most recent evolution in CMOS logic has been in reducing supply voltage without sacrificing performance. The new LCX family is one outgrowth of this trend. This family results from the joint efforts of a triumvirate of companies including Motorola, National, and Toshiba. Although each company has done its own design and fabrication, they have mutually agreed to provide identical performance specifications. In addition to the 3V operating voltage, LCX inputs and outputs are tolerant of interfacing with 5V devices.





## ECL

Emitter-coupled logic (ECL) derives its name from the differential-amplifier configuration in which one side of the diff-amp consists of multiple-input bipolar transistors with their emitters tied together. An input bias on the opposite side of the diff-amp causes the amplifier to operate continuously in the active mode. Consequently, ECL consumes a relatively substantial amount of power in both states (one or zero) but also results in the fastest switching speeds of all logic families. An inherent benefit of ECL is the narrow switching level swing between devices (approximately 800 mV) which helps to reduce noise generation.

There have also been many evolutionary advancements in ECL, the following being some of the most prominent: 100K (1975), 10KH (1981), and ECLinPS™ (1987). Of most recent vintage is the ECLinPS Lite™ family of single function devices. By focusing on simplicity, this family achieves very high performance, while at the same time reducing package size.

### Speed

Speed is typically the first parameter at which a designer looks, and when design engineers are asked what features of a logic family they would like enhanced, usually they want more speed. But increased speed often brings along many potential problems such as: increased noise generation, higher power consumption, increased component and system cost, more difficult board layout, etc. An assessment of the other family parameters is usually required before a final selection is possible.

In Table 1. , family speed is compared for three parameters using typical values: propagation delay through a simple OR gate, flip-flop toggle frequency, and output switching time. Typical values can be misleading as they are frequently specified according to different vendor's criteria, but they are usually close to an average of min and max values. For final assessment of a particular component's performance, the min/max spec's provided in most vendor's data sheets should be examined. Furthermore, switching (edge) rate is highly load dependent, and again, data sheet specifics must be compared.

## Power Consumption

The amount of power an application consumes (and the subsequent heat generated) is frequently of prime importance. One of the major differences between the three families, the power parameter may also limit the designer's choices.

TTL consumes a moderate amount of power and is nearly constant over operating frequencies up to about 10 MHz; above 10 MHz it begins to climb rapidly. Although only a few milliwatts are consumed by each device, in a complete system a substantial amount of power may be used.

CMOS power consumption, on the other hand, is highly frequency dependent. In quiescent mode (zero frequency), it consumes almost no power at all, being measured in microwatts/device. However, its consumption grows almost linearly with frequency so that at maximum operating frequency it may be several milliwatts/device. The great power reduction advantage of CMOS derives from the fact, that in most applications, the percentage of the total number of devices operating at high frequencies at any given time is small; consequently, the average total power consumed by the system is greatly diminished.

Since power consumption is proportional to the square of supply voltage, simply reducing the operating voltage will have desirable effects. Unfortunately, speed generally falls off as well. By designing the LCX family specifically for a lower supply voltage, it was possible to maintain high overall performance. The LCX family is also designed to interface with five volt devices, being tolerant of the differences in I/O levels.

Because of its inherent design, ECL is the highest power consumer at frequencies below approximately 50 MHz; however, at higher frequencies, TTL and CMOS power consumption can exceed ECL. The amount of power used by ECL is fairly constant over its entire operating frequency range. Designers of large, high performance ECL systems may have to employ somewhat more complex cooling and power distribution techniques.

## Supply Voltage

The power supply voltage required for TTL and ECL is restricted to fixed values; only a narrow voltage variation is allowed for the device to remain within specifications. Since these families also consume substantial amounts of power, there is a large current flow through the power lines. To avoid unacceptable voltage fluctuation, various preventive measures may be necessary such as remote sensing by the supply regulator, beefing up power buses and filters, and utilizing multi-layer PC boards with separate power and ground planes. Typically, a high-speed energy storage capacitor is required near each logic device; this capacitor maintains the correct device voltage during high-current switching.

An important advantage of CMOS is the large range of supply voltage over which operation is specified. By allowing systems to be operated at voltages as low as 2V, not only is power consumption lowered, but noise generation from fast signal switching is reduced. It must be noted, however, that operating speed drops off rapidly as the voltage is reduced. As mentioned previously, this was a significant reason for developing the LCX family.

## Output Drive

An important characteristic of a logic device is its ability to drive relatively large loads without significant speed degradation. The older families within TTL, and especially CMOS, had only limited drive capability (below 10 mA). All advanced logic family versions have significantly increased drive capacity, and several (FACT, LCX and all ECL) are capable of driving 50 ohm transmission lines directly. Furthermore, because of the symmetrical sink/source capability of FACT and LCX, their rise and fall times are nearly equal, resulting in balanced delay times.

## 5V Tolerant Input/Output

Because of the limited number of functions available in the new low voltage CMOS families, a designer might have to mix 3V and 5V devices, each operating from 3V and 5V rails, respectively. Unless the 3V device was specifically designed with proper protection to tolerate 5V at its input or output, it may not survive.

## Noise Margin

Noise immunity refers to the resistance of a logic device to undesired switching. Depending on the input level, a noise glitch that causes a transient across the input switch point from either a high or low level can result in erroneous operation. Clearly, the more voltage difference there is between the switch point and the normal input high and low levels, the more immunity a logic family has to erroneous switching. In Table 1, these differences are expressed as a percentage of the swing between typical output high and low voltage logic levels. High input noise margin is calculated from the formula:

$$\text{HNM} = \frac{V_{OH} - V_{IH}}{V_{OH} - V_{OL}}, \text{ and for low input noise margin,}$$

$$\text{LNM} = \frac{V_{IL} - V_{OL}}{V_{OH} - V_{OL}}.$$

## Packaging

The venerable Dual-Inline package (DIP) is rapidly being replaced by Small Outline (SO), Shrink Small Outline (SSOP), Thin Shrink Small Outline (TSSOP), and Leadless Chip Carrier (LCC) packages for surface mounting. Savings in footprint area of up to 90% are possible with these newer packages.

## Device Types

In general, the older the family the larger the quantity of different functional devices available. This is only natural since it takes time (and substantial resource investment) to design and reliably manufacture increasingly more complex devices. The newer TTL and CMOS families will undoubtedly grow, but because of competition from higher integrated devices, will be more limited in scope.

## Cost

Here again, the age of a family has a substantial bearing on its relative selling price. The older families have benefited longer from manufacturing learning and volume curve cost reductions. Newer technologies, because of their inherently more complex process requirements, increased performance improvements, and higher cost of production, are priced higher but should decline over time.

## Mix and Match

Many designers have found that the best approach to achieving their particular application performance goal is to combine devices from several families. The obvious advantage of this is to optimize the requirements of selected portions of a design, whether it is for speed, power consumption, output drive, cost, etc. Some disadvantages are that devices must be analyzed and tested for compatibility, inventories may increase, and some performance parameters may be compromised.

## Conclusion

The diversity of logic families available to today's logic designer may be likened to a bad news/good news scenario. The bad news is that you have huge ratios between the highest and lowest performance values—speeds of 500:1, power at 100,000:1, output drive at 24:1, etc. The good news is that you have lots of choices—it wasn't too many years ago that there were very few. By examining and comparing each family's parameters, an optimal selection can result.

A few potential users of standard logic devices may worry, that because of the trends towards higher-integration chips, some vendors will abandon the older product lines. This may *eventually* happen; however, the current demand, projected for at least the next decade, indicates that these families have a very solid future. The diverse applications that keep arising for semiconductor products that are inexpensive and reliable continue to mount. Until some totally revolutionary development should occur, these "oldies, but goodies" will be around for a long time to come.



# INTRODUCTION TO MOTOROLA PROGRAMMABLE ARRAYS

Field programmable logic and in particular, field programmable arrays, have become the solution of choice for logic design implementation in applications where time to market is a critical product development factor. In addition, reconfigurable arrays have been used to enhance Customer product flexibility in ways that no other technology can match.

Microprocessors have traditionally been used to satisfy time to market and end product flexibility needs. This solution may not meet performance constraints and lacks the concurrency possible in an unconstrained hardware design. Typical design processes, therefore, reach a point where the overall design is partitioned into hardware and software components. An interface is defined and the design process continues along two parallel paths. Sometime later, the software and hardware components must be integrated. Problems usually develop at this point because of interface misinterpretation or partitioning that cannot meet design requirements. This impacts the hardware, the software and the schedule. If the hardware design is realized in programmable logic, the hardware can be manipulated as easily as the software.

Products which adapt to the end users particular requirements through self directed or end user directed reconfiguration are becoming more prevalent. As the number of modes of operation increases, mode specific hardware becomes a less cost effective solution. In the case where the end user is truly directing the adaptation, predetermined hardware solutions become untenable. Reconfigurable logic enables design solutions where dynamic hardware–software repartitioning is possible.

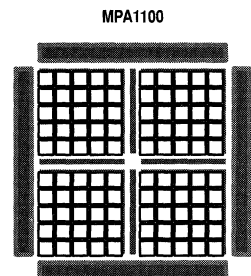
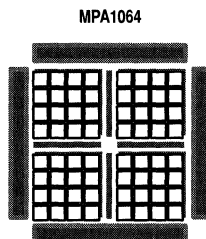
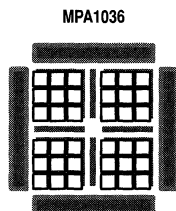
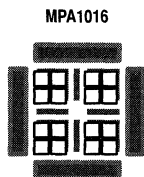
Programmable logic not only vastly improves the time necessary to implement a static design, but significant time to market and product feature benefits can be realized when hardware can be dynamically altered as easily as software.

To reduce design cycles, designers have also turned towards high level design languages and logic synthesis tools. Many programmable logic solutions are poorly suited to this design methodology, however. An incompatibility exists between logic synthesis algorithms originally developed for gate level design and the block-like structures found on many programmable logic devices. This can result in significant under utilization or degraded performance. In either case a more expensive device is required. Real gate level programmable devices are ideally suited to this design methodology.

When schematic based design methods are used, some programmable logic solutions impose significant constraints on design implementation to insure satisfactory results. This imposition tends to bind the design to a particular programmable device and requires a significant learning investment. Any design specification changes which impact design decisions made to fit this imposed structure can have disastrous effects on utilization and performance and potentially require a more expensive device or even a costly redesign. Gate level programmable devices coupled with sophisticated, timing driven, implementation tools minimize device specific optimization.

Any design process includes a significant amount of learning. Usually engineers spend most of this time learning about product requirements or prototyping critical portions of the design to prove implementation feasibility. Many programmable logic solutions are not push button; time must be spent learning programmable device architecture or implementation tool quirks. Worse yet, the design may require modification or manual component placement to meet design targets. The cost? Time to market.

The reconfigurable Motorola Programmable Array (MPA) and MPA design system maximize application flexibility and minimize time to market by delivering a gate level, push button, programmable logic solution.



# MPA1000 Programmable Arrays

Motorola Programmable Array (MPA) products are a high density, high performance, low cost, solution for your reconfigurable logic needs. When used with our automatic high performance design tools, MPA delivers custom logic solutions in minutes rather than weeks. And the low cost keeps those solutions competitive throughout the product lifecycle.

The MPA architecture has solved the historical problems associated with fine grain devices without sacrificing re-programmability, reliability, or cost. MPA1000 devices are reprogrammable SRAM based products manufactured on a standard 0.5 $\mu$  Leff CMOS process with logic capacities from 3,500 to more than 22,000 equivalent FPGA gates. MPA Logic resources hold a single gate or storage element providing a highly efficient, adaptable, design migration medium. Gate level logic resources, abundant hierarchical interconnection resources and automatic, timing driven, tools work together to quickly provide design implementations that meet timing constraints without sacrificing device utilization.

Staying focused on end product design rather than implementation tools or device architecture gets the design done faster and, unlike other programmable solutions, without programmable logic device specificity to impede future design migration efforts. The combination of automatic tools and gate level architecture is ideal for traditional schematic driven or high level language based design methodologies. In fact, logic synthesis tools were originally designed for and produce the most efficient results when targeting gate level devices.

High MPA1000 register count and controlled clock skew is ideal for designs employing pipelining techniques such as communications. The unique set of MPA1000 I/O programming options make these devices suitable for industrial and computer interfacing circuits.

**MPA1016**  
**MPA1036**  
**MPA1064**  
**MPA1100**

**PROGRAMMABLE ARRAY**  
**3,500 to 22,000 GATES**

- Multiple I/O from 80–200 I/O Pins
- Programmable 3V/5V I/O at Any Site
- Multiple Packaging Options.
- Fine Grain Structure Is Optimized for Logic Synthesis
- Programmable Output Drive, 6/12mA @ 5.0V
- High Register Count, with 560–2,900 Flip-Flops
- IEEE 1149.1 JTAG Boundary Scan
- Eight Low-Skew (<1ns) Clocks

## MPA1000 Family Members

FPGA Gates*	Part No.	Logic Cells	Internal Flip-Flops	I/O Cell Flip-Flops	Avail I/O Pins	Packages	Availability
3500	MPA1016FN MPA1016DD	1600	400	122	61	84 PLCC	NOW
				160	80	128 PQFP	NOW
8000	MPA1036FN MPA1036DD MPA1036DH MPA1036HI	3600	900	122	61	84 PLCC	NOW
				160	80	128 PQFP	NOW
				240	120	160 PQFP	NOW
				240	120	181 PGA	NOW
14200	MPA1064DH MPA1064DK MPA1064KE MPA1064BG	6400	1600	240	120	160 PQFP	NOW
				320	160	208 PQFP	NOW
				320	160	224 PGA	NOW
				320	160	256 PBGA	3Q97
22000	MPA1100DK MPA1100HV MPA1100BG	10000	2500	320	160	208 PQFP	NOW
				400	200	299 PGA	NOW
				400	200	256 PBGA	3Q97

\* Equivalent to Industry Standards, as supplied by most manufacturers.

## MPA1000 Serial EPROM Family

Capacity	MPA Companion Devices	Part Number	Packages	Availability	Notes
64K	MPA1016	MPA1765P MPA1765D MPA1765FN	8 DIP 8 SOIC 20 PLCC	NOW	OTP
128K	MPA1036	MPA17128P MPA17128D MPA17128FN	8 DIP 8 SOIC 20 PLCC	NOW	OTP
256K	MPA1064	MPA17C256P MPA17C256D MPA17C256FN	8 DIP 20 SOIC 20 PLCC	2Q97	Erasable

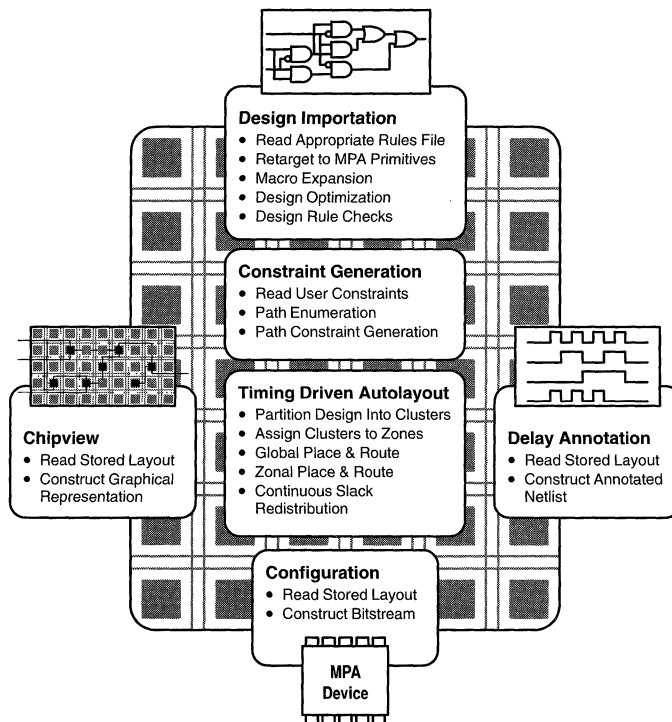
# MPA1000 Design System Product Description

## Overview

The Motorola Programmable Array (MPA) design system is a bridge between a design capture environment and Motorola field programmable arrays. The MPA design system automatically transforms designs into device configurations which, when loaded into an MPA device, realize a design. A design is automatically analyzed, optimized, transformed into MPA cells, partitioned, placed and routed based on timing constraints for every path in the design. MPA design tools understand and optimally utilize the MPA device architecture; this eliminates the need to learn a new set of rules and makes these tools ideally suited for use with logic synthesis. Full incremental design support reduces design implementation time and powerful library retargeting capabilities allow you to reuse designs which may have been implemented on less capable devices. The MPA design system operates on existing hardware platforms and supports design capture and simulation tools from more than 10 vendors. All these features plus on-line, hypermedia, help make the MPA design system a powerful yet extremely easy to use design implementation engine.

## Features

- Push Button Implementation
- Optimal Use of MPA Device Resources
- Optimal Results with Gate Level Design Input
- Library of Common MSI Functions
- Design Flow Manager
- Design Retargeter
- Timing Driven with Integrated Static Timing Analysis
- Layout Delay extraction for post layout simulation
- Layout viewer
- Incremental design support
- On-line, hypermedia, documentation
- Supports all popular design capture and simulation tools
- Lowest cost FPGA development systems.
- Instant access; Downloading via the internet (WWW, ftp).



## Push Button Design Implementation

The MPA design system minimizes training investment and automatically generates design implementations which meet timing constraints.

The gate level logic and abundant hierarchical routing resources of the MPA device present a rich implementation media for design implementation. MPA design tools understand and optimally utilize the MPA device resources so there are no elaborate rules to learn or design modifications required to begin design capture. Staying focused on end product design rather than implementation tools or device architecture gets the design done faster and, unlike other programmable solutions, without programmable logic device specificity to impede future design migration efforts. The combination of automatic tools and gate level architecture is ideal for traditional schematic driven or high level language based design capture methods. In fact, logic synthesis tools were originally designed for and produce the most efficient results for targeting gate level devices.

A design is analyzed, optimized, transformed into MPA cells, partitioned, placed and routed based on timing constraints for all paths in the design – automatically. A netlist from one of the popular design capture systems or an existing XNF or LPM netlist is imported into the MPA design system. The logic is mapped to a series of MPA cells and the entire resulting netlist is optimized and checked. Based on a simple clock specification, the MPA design system generates timing constraints for all paths in the design. During automatic partitioning, placement and routing path slack time is constantly redistributed insuring only the resources required to meet timing requirements are consumed. Because MPA tools implement the design according to constraints, tool induced design iterations are virtually eliminated. Completed layouts can be transformed into device configurations, as well as annotated simulation netlists. A layout browser is also available.

The MPA design system also includes complete on–line, hypermedia, help covers the device, the design system and the integration kits. Integration kits for Viewlogic, Exemplar, VHDL (1076), Verilog (OVI) and OrCAD are included (contact your vendor for additional kits). All these features add up to a powerful yet extremely easy to use design implementation engine for the MPA product family.

## Design Importation

Designs can be captured using schematics, a high level language, or a combination of these entry methods using commercially available design capture and logic synthesis software and the appropriate interface kit. Alternatively, existing designs can be retargeted from other programmable logic devices to the MPA device using commercial logic synthesis tools or the powerful retargeting capabilities provided with MPA design system.

Design importation begins with a netlist and an optional clock specification file. The clock specification file provides a mechanism for the user or design capture tools to document system level timing requirements. In addition, a rich set of attributes can be attached to specific components

or nets within the design to specify timing and design pinout constraints.

A retargeting rules file is read and the input netlist is transformed into a series of MPA cells and associated interconnections. Rules files provide a mechanism to perform attribute mapping, cell mapping and macro expansion. By creating custom rule files, the user can extend the importation process from arbitrary sources. The MPA design system comes with rules for it's native library/EDIF. The resulting netlist is optimized to clip unused logic and remove redundant logic. For example: each MPA cell has programmable input inversion capability. All Inverters or non–inverting buffers can be removed from the netlist and replaced with signal sense information attached to each input.

A series of design rule checks are performed to insure design integrity before the layout process begins.

## Constraint Generation

Timing constraints, the optimized MPA netlist and static timing analysis is used to generate path slack constraints for all paths in the design. Each unique signal pathway between a register output and a register input throughout the design are enumerated. The total logic and estimated or real wire delays along the path are summed. The time between the active upstream register clock edge and the next active downstream clock edge minus the downstream register setup time is subtracted from the total path delay. This difference is called path slack. If any path in the design has a negative slack value, the implementation will not function at the required clock rate(s).

Path constraints are utilized throughout the layout process to insure that a design implementation which meets timing constraints is automatically generated. If no clock or timing specifications are provided, the MPA design system uses the fastest possible clock based on very small net delay estimates to generate the path constraints. This usually results in the best possible implementation, but may take longer than the time required to generate a satisfactory rather than best possible result.

Contrast this to other programmable logic design tools which only provide manual net constraint annotation or net criticality assignment. In these cases significant effort is necessary to generate constraints and many costly iterations are required to tune these constraints for a given design. If any changes are made to the design, another costly round of iterations is required.

## Autolayout

The autolayout process makes use of the hierarchical organization of the MPA device to minimize run time and deliver implementations that meet timing requirements. Designs which have diverse timing requirements are ideally implemented because path slack estimates are refined throughout the autolayout process insuring only the resources required to meet timing requirements are consumed.

The process begins by flattening the design and partitioning it into small component groups of approximately the same size called clusters. A cluster boundary delay

estimation is applied to pull the most tightly constrained paths into a minimum number of clusters. The clusters are then assigned to zones taking into account zonal boundary delay cost and relative zone placement delay costs. Other costs like total number of port connections per zone and are also considered. As assignment proceeds, cluster and zone boundary delay costs are added to each path and slack is recomputed.

Next global placement and routing is done. Global routes begin and end on either I/O cells or port cells. Intrazone placement and routing is deferred to a later phase. During global routing all the port cell and I/O cell locations are fixed and the connections between them established. High fanout nets are constructed in a highly regular manner to insure efficient resource utilization. As in partitioning, slack estimates are refined throughout global routing.

Finally the intrazonal placement and routing is done. Cells assigned to a particular zone are placed and routed to other zone cells or zone port cells. Port cells and core cells are constructed to allow port swapping. Core cells can be routed through if necessary. Allowing core cells to act as routing cells allows dynamic adjustment of routing resources within the zone. Dynamic resource adjustment is a powerful design specific adaptation mechanism.

This process produces a layout from which device configurations, delay back annotations, and chipviews can be generated.

#### **Incremental Design Support**

When specification changes necessitate design iterations, simply push the button again. Constraints are automatically recalculated and autolayout only reworks those portions of the design which have changed. Full incremental design support means simple design changes to facilitate design verification can be made quickly and easily.

#### **Delay Back Annotation**

Designs can be verified through numerous methods. One particularly useful method is the annotation of device and implementation specific delays back into the original simulation environment to improve system or device level

simulation accuracy. A MPA device layout can be transformed into an appropriately formatted delay annotation file or annotated netlist quickly and easily. The annotated delay information represents the worst case delays for a given device speed grade.

#### **Chipview**

While the MPA design system provides a rich set of reports describing the implementation of a design, a graphical view of the implementation can be indispensable for reviewing overall layout quality. Chipview provides a graphical view of a completed layout. Chipview can be useful during initial design iterations to visually verify I/O pin placements before commencing PCB layout, for example.

#### **Configuration**

A layout can be transformed into a device configuration which, when loaded into the appropriate MPA device, produces a physical design realization. Many formatting options are available. The MPA download pod can be used to emulate a serial PROM. Using the pod, device configuration files can be downloaded to a device directly from the PC or workstation development environment.

#### **Integration Kits**

The MPA design system can be used with a large number of commercial electronic design automation software. For each supported vendor, an integration kit is provided which facilitates MPA design within that vendors' environment. Many of these kits are available from Motorola and included at no charge on the MPA design system CDROM. Other kits can be acquired directly from the vendor. Refer to the MPA Design System Product List for more information.

#### **Low Cost, Easy Access**

MPA Design systems are easy to use, competitively priced and widely available. Copies of MPA design system software supporting up to 8000 gates can be downloaded from the World Wide Web (WWW) @ <http://sps-mot.com/fpga>. Complete kits including download pod, evaluation board, MPA device, CDROM and documentation can be ordered from your local authorized Motorola distributor or Motorola sales representative.

*Fast, Efficient Design Implementation With Minimal Investment.  
That's MPA!*

# Design System Product List

## MPA Design Kits and Options

Part Number	Description	Platform		CDROM	Supports 1016/1036	Supports All MPAs	Eval Board	POD	Maintenance
		PC	WS						
MPA1E/P	Entry Level Kit	X		X	X		X	X	
MPA1E/W	Entry Level Kit		X	X	X		X	X	
MPA1S/P	Standard Kit	X		X	X	X	X	X	1 Year
MPA1S/W	Standard Kit		X	X	X	X	X	X	1 Year
MPA1CD/P	Design Software CD	X		X	X				
MPA1CD/W	Design Software CD		X	X	X				
MPA1/POD	Download Pod	X			X	X		X	
MPA1/BRD	Evaluation Board		X		X		X		
MPA1M12P	Maintenance	X							1 Year
MPA1M12W	Maintenance		X						1 Year

### MPA Design Kit Description

- MPA Design System Software on CDROM
  - Design Import and Retargeting
  - Timing Driven Placement and Routing
  - Layout Viewer
  - Layout Delay Extraction (Annotation)
  - Incremental Design
  - On-Line MPA Device and Design Kit Help
- MPA Device Support
  - Entry Level: MPA1016, MPA1036
  - Standard Level: All MPA1000 Devices
- Evaluation Board with MPA Device (MPA1/BRD)
- Download POD (MPA1/POD)
- 12 Months Maintenance with Standard Kits
- All Integration Kits\*

\*The MPA Design System CDROM contains integration kits for Viewlogic, Exemplar, Synopsys, VHDL (1076), Verilog (OVI), and OrCAD. For other integration kits, contact your EDA vendor.

### MPA Design System Maintenance

- Support Line Access 1-800-521-6274
- Upgrades

### MPA Design System Download POD

- RS232 Connection to Host Computer
- Emulates Serial PROM
- Loads MPA Device via Host Computer

### MPA Design System Evaluation Board

- MPA Device
- Simple PCB Facilitating MPA Evaluation

### Platform Requirements

- PC Platform – 33MHz 486, 16Mb RAM, 32Mb Swap, 40MB Free Disk Space, Serial Port, Windows 3.1 or Later, Windows/NT
- Sun Platform Requirements: Sun SPARC Compatible, 32Mb RAM, 40Mb Swap, 60Mb Free Disk Space, SunOS 4.1.3, Solaris 2.3, Windows Manager: OSF/MOTIF 1.2 X11r5

MPA integrated front-to-back solutions, including schematic, VHDL entry, logic simulation and MPA device software, are also available. Contact the factory for details on a 30-day evaluation copy!

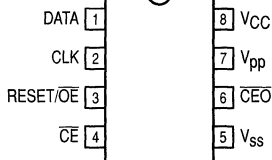
# MPA17000 Serial EPROMs

The MPA17128, MPA1765 serial OTP EPROMs provide a compact, low pin count, non-volatile configuration store for MPA1000 devices.

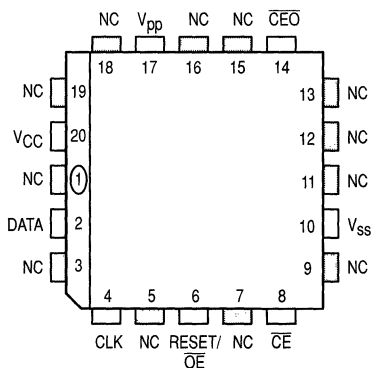
MPA17000 devices can be cascaded for increased memory capacity when needed. They are available in the standard 8-pin plastic DIP (N suffix), 8-pin SOIC (D suffix) and 20-pin PLCC (FN suffix) packages.

- Configuration EPROM for MPA1000 Devices
- Voltage Range – 4.5 to 6.0V
- Maximum Read Current of 10mA
- Standby Current of 10µA, Typical
- Industry Standard Synchronous Serial Interface
- Full Static Operation
- 10MHz Maximum Clock Rate at 5.0V
- Programmable Polarity on Hardware Reset
- Programs With Industry Standard Programmers
- Electrostatic Discharge Protection > 2000 Volts
- 8-Pin PDIP and SOIC; 20-Pin PLCC Packages
- Commercial (0 to +70°C) and Industrial (–40 to +85°C)

**8-Lead Pinouts**  
(Top View)

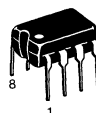


**20-Lead Pinout**  
(Top View)



## MPA17128 MPA1765

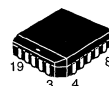
### 128K, 64K SERIAL EPROM



**P SUFFIX**  
PLASTIC PACKAGE  
CASE 626-05



**D SUFFIX**  
PLASTIC SOIC PACKAGE  
CASE 751-05



**FN SUFFIX**  
PLCC PACKAGE  
CASE 775-02

#### PIN NAMES

Pins	Function
DATA	Data I/O
CLK	Clock
RESET/OE	Reset Input and Output Enable
CE	Chip Enable Input
VSS	Ground
CEO	Chip Enable Output
Vpp	Programming Voltage Supply
VCC	+4.5 to 6.0V Power Supply
NC	Not Connected

# Selection by Function

In order to better serve our customers, we have made some modifications to the Selection by Function portion of the Logic Selector Guide. For easy selection of Logic's newer, more complex functions, as well as standard family functions, refer to the subject index below. Within the Selection by Function tables on the next 23 pages, you will find functions sorted by these broad subjects, and then broken down alphabetically into more precise functions.

## Logic Functions

AMPLIFIER .....	3.1-13	GATES, OR .....	3.1-28
ARITHMETIC OPERATORS .....	3.1-13	INDUSTRIAL CONTROL UNIT .....	3.1-29
BOUNCE ELIMINATOR .....	3.1-13	INVERTERS .....	3.1-29
BUFFERS .....	3.1-13	INVERTER/BUFFERS, 2-STATE .....	3.1-29
BUFFERS, 3-STATE .....	3.1-13	LATCHES .....	3.1-30
BUS INTERFACE .....	3.1-14	MEMORY SUPPORT .....	3.1-31
CBM .....	3.1-16	MISCELLANEOUS .....	3.1-31
CLOCK DISTRIBUTION CHIPS .....	3.1-16	MULTIPLEXER/DATA SELECTORS .....	3.1-31
CLOCK DRIVERS .....	3.1-16	MULTIVIBRATORS .....	3.1-33
COAX CABLE DRIVERS .....	3.1-17	OSCILLATORS .....	3.1-33
COMPARATORS .....	3.1-17	OSCILLATOR/TIMERS .....	3.1-34
CONVERTERS .....	3.1-18	PARITY CHECKERS .....	3.1-34
COUNTERS .....	3.1-18	PHASE-LOCKED LOOP .....	3.1-34
DECODER/DEMULTIPLEXERS .....	3.1-20	PRESCALERS .....	3.1-34
DETECTORS .....	3.1-21	PROGRAMMABLE DELAY CHIPS .....	3.1-35
DISPLAY DECODE DRIVERS .....	3.1-21	PROMs .....	3.1-35
DIVIDERS .....	3.1-21	RAMs .....	3.1-35
DRIVER .....	3.1-21	RECEIVERS .....	3.1-35
EDACs .....	3.1-21	REGISTERS .....	3.1-36
ENCODERS .....	3.1-21	REGISTER FILES .....	3.1-36
ENCODER/DECODERS .....	3.1-22	SCHMITT TRIGGERS .....	3.1-36
EXPANDERS .....	3.1-22	SCSI BUS TERMINATORS .....	3.1-36
FIELD PROGRAMMABLE GATE ARRAYS .....	3.1-22	SERIAL EPROMs .....	3.1-36
FLIP-FLOPS .....	3.1-22	SHIFT REGISTERS .....	3.1-36
GATES, AND/NAND .....	3.1-25	SYNTHESIZERS .....	3.1-38
GATES, COMPLEX .....	3.1-26	TRANSCIVERS .....	3.1-38
GATES, EXCLUSIVE OR/EXCLUSIVE NOR .....	3.1-27	TRANSLATORS .....	3.1-38
GATES, NOR .....	3.1-28	VCO .....	3.1-39



## Selection by Function

Description	Tech.	Device(s)	Pins	DIP	SM
<b>AMPLIFIER</b>					
Fiber Optic Post Amplifier	ECL	MC10SX1125	–	16	D
<b>ARITHMETIC OPERATORS</b>					
4–Bit Arithmetic Logic Unit	TTL	MC74F181	–	24	N, DW
	TTL	MC74F381	–	20	N, DW
	TTL	MC74F382	–	20	N, DW
	TTL	SN54LS181	SN74LS181	24	N,J, DW
4–Bit Arithmetic Logic Unit/Function Generator	ECL	MC10H181	–	24	P,L, P,W, LW, FN
	ECL	MC10181	–	24	P,L
4–Bit Binary Full Adder With Fast Carry	TTL	MC74F283	–	16	N, D
	TTL	SN54LS83A	SN74LS83A	14	N,J, D
	TTL	SN54LS283	SN74LS283	16	N,J, D
4–Bit Full Adder	CMOS	MC14008B	–	16	P,L, D
9's Complementer	CMOS	MC14561B	–	14	P, D
BCD Rate Multiplier	CMOS	MC14527B	–	16	P, DW
Carry Lookahead Generator	TTL	MC74F182	–	16	N, D
Dual 2–Bit Adder/Subtractor	ECL	MC10H180	–	16	P,L, FN
	ECL	MC10180	–	16	P,L
Look Ahead Carry Block	ECL	MC10H179	–	16	P,L, FN
NBCD Adder	CMOS	MC14560B	–	16	P,L, D
Triple Serial Adder (Negative Logic)	CMOS	MC14038B	–	16	L
<b>BOUNCE ELIMINATOR</b>					
Hex Contact Bounce Eliminator	CMOS	MC14490	–	16	P,L, DW
<b>BUFFERS</b>					
1:2 Differential Fanout Buffer	ECL	MC100LVEL11	–	8	D
2:8 Differential Fanout Buffer	ECL	MC100LVE310	MC100E310	28	FN
Dual 1:3 Fanout Buffer	ECL	MC100LVEL13	MC100EL13	20	DW
Expandable Buffer	DTL	MC832	–	14	P,L
Low Voltage Dual 1:4, 1:5 Differential Fanout Buffer, ECL/PECL Compatible	ECL	MC100LVE210	MC100E210	28	FN
<b>BUFFERS, 3–STATE</b>					
Low–Voltage CMOS 16–Bit Buffer, 3–State, Inverting With 5V Tolerant Inputs and Outputs	CMOS	MC74LCX16240A	–	20	DW,M, DT
Low–Voltage CMOS 16–Bit Buffer, 3–State, Non–Inverting With 5V Tolerant Inputs and Outputs	CMOS	MC74LCX16244	–	20	DW,M, DT
Low–Voltage CMOS Octal Buffer, 3–State, Non–Inverting With 5V Tolerant Inputs and Outputs	CMOS	MC74LCX244	–	20	DW,M, DT
Low–Voltage CMOS Octal Buffer, 3–State, Inverting With 5V Tolerant Inputs and Outputs	CMOS	MC74LCX240	–	20	DW,M, DT
Low–Voltage CMOS Octal Buffer Flow Through Pinout, 3–State, Non–Inverting With 5V Tolerant Inputs and Outputs	CMOS	MC74LCX541	–	20	DW,M, DT
Low–Voltage CMOS Octal Buffer Flow Through Pinout, 3–State, Inverting With 5V Tolerant Inputs and Outputs	CMOS	MC74LCX540	–	20	DW,M, DT
Low–Voltage CMOS Quad Buffer, 3–State, Inverting With 5V Tolerant Inputs and Outputs	CMOS	MC74LCX125	–	20	DW,M, DT
Low–Voltage Quiet CMOS Octal Buffer	CMOS	MC74LVQ541	–	20	D,M, SD,DT
Low–Voltage Quiet CMOS Octal Buffer, 3–State, Non–Inverting	CMOS	MC74LVQ244	–	20	DW,M, SD,DT

## Selection by Function

Description	Tech.	Device(s)		Pins	DIP	SM	
<b>BUFFERS, 3-STATE</b>							
Low-Voltage Quiet CMOS Octal Buffer, 3-State, Inverting	CMOS	MC74LVQ240	–	20		DW,M, SD,DT	
Low-Voltage Quiet CMOS Quad Buffer, 3-State, Non-Inverting	CMOS	MC74LVQ125	–	14		D,M, SD,DT	
<b>BUS INTERFACE</b>							
10-Bit Buffer/Line Driver (Inverting), With 3-State Outputs	TTL	MC74F828	–	24	N	DW	
10-Bit Buffer/Line Driver (Non-Inverting), With 3-State Outputs	TTL	MC74F827	–	24	N	DW	
3-Bit Registered Bus Transceiver, 25Ω Cutoff Outputs	ECL	MC10E336	MC100E336	28		FN	
3-Bit Scannable Registered Bus Transceiver	ECL	MC10E337	MC100E337	28		FN	
32-Bit to 32/16/8-Bit Dynamic READ/WRITE Bus Sizer	CMOS	MC68150*33	–	68		FN	
	CMOS	MC68150*40	–	68		FN	
9-Bit Bus Interface, NINV, 3 State Outputs	TTL	MC74F823	–	24	N	DW	
Bus Driver	ECL	MC10128	–	16	L		
Dual Bus Driver/Receiver With 4-to-1 Output Multiplexer (25Ω)	ECL	MC10H332	–	20	P,L	FN	
Hex 3-State Inverting Buffer With Common Enables	CMOS	MC54HC366	MC74HC366	16	N,J		
Hex 3-State Inverting Buffer With Separate 2-Bit and 4-Bit Sections	CMOS	MC74HC368	–	16	N		
Hex 3-State Non-Inverting Buffer With Common Enables	CMOS	MC54HC365	MC74HC365	16	N,J	DT	
Hex 3-State Non-Inverting Buffer With Separate 2-Bit and 4-Bit Sections	CMOS	MC54HC367	MC74HC367	16	N,J		
Hex Buffer 4/2-Bit/Inverting With 3-State Outputs	TTL	SN54LS368A	SN74LS368A	16	N,J	D	
Hex Buffer 4/2-Bit/Non-Inverting With 3-State Outputs	TTL	SN54LS367A	SN74LS367A	16	N,J	D	
Hex Buffer Driver, 4+2-Bit, Inverting, With 3-State Outputs	TTL	MC74F368	–	16	N	D	
Hex Buffer Gated Enable Inverting With 3-State Outputs	TTL	SN54LS366A	SN74LS366A	16	N,J	D	
Hex Buffer Gated Enable Non-Inverting With 3-State Outputs	TTL	SN54LS365A	SN74LS365A	16	N,J	D	
Hex Buffer/Driver Gated Enable Inverting, With 3-State Outputs	TTL	MC74F366	–	16	N	D	
Hex Buffer/Driver Gated Enable Non-Inverting, With 3-State Outputs	TTL	MC74F365	–	16	N	D	
Hex Buffer/Driver, 4+2-Bit, Non-Inverting, With 3-State Outputs	TTL	MC74F367	–	16	N	D	
Hex With 3-State Outputs Buffer (Non-Inverting)	CMOS	MC14503B	–	16	P,L	D	
Octal 3-State Non-Inverting Bus Transceiver With LSTTL Compatible Inputs	CMOS	MC54HCT245A	MC74HCT245A	20	N,J	DW, SD,DT	
Octal Bidirectional Transceiver With 3-State Inputs/Outputs	CMOS	MC74AC245	–	20	N	DW	
	CMOS	MC74ACT245	–	20	N	DW	
Octal Bidirectional Transceiver With 3-State Outputs	CMOS	MC74AC620	–	20	N	DW	
	CMOS	MC74ACT620	–	20	N	DW	
	CMOS	MC74AC623	–	20	N	DW	
	CMOS	MC74ACT623	–	20	N	DW	
	CMOS	MC74AC640	–	20	N	DW	
	CMOS	MC74ACT640	–	20	N	DW	
	CMOS	MC74AC643	–	20	N	DW	
	CMOS	MC74ACT643	–	20	N	DW	
	TTL	MC74F245	–	20	N	DW	
	Octal Bidirectional Transceiver With 8-Bit Parity Generator Checker, With 3-State Outputs	TTL	MC74F657A	–	24	N	DW
TTL		MC74F657B	–	24	N	DW	
Octal Bidirectional Transceiver, With 3-State Inputs/Outputs	TTL	MC74F1245	–	20	N	DW	
Octal Buffer With 3-State Outputs	(81LS95)	TTL	SN54LS795	SN74LS795	20	N,J	DW
	(81LS96)	TTL	SN54LS796	SN74LS796	20	N,J	DW
	(81LS97)	TTL	SN54LS797	SN74LS797	20	N,J	DW
	(81LS98)	TTL	SN54LS798	SN74LS798	20	N,J	DW

## Selection by Function

Description	Tech.	Device(s)		Pins	DIP	SM
<b>BUS INTERFACE</b>						
Octal Buffer/Line Driver With 3-State Outputs	TTL	SN54LS244	SN74LS244	20	N,J	DW
	TTL	MC74F240	–	20	N	DW
	TTL	MC74F241	–	20	N	DW
	TTL	MC74F244	–	20	N	DW
	TTL	SN54LS240	SN74LS240	20	N,J	DW
	TTL	SN54LS241	SN74LS241	20	N,J	DW
	TTL	SN54LS540	SN74LS540	20	N,J	DW
	TTL	SN54LS541	SN74LS541	20	N,J	DW
	CMOS	MC74AC241	–	20	N	DW
	CMOS	MC74AC244	–	20	N	DW
	CMOS	MC74ACT244	–	20	N	DW
	CMOS	MC74AC540	–	20	N	DW
	CMOS	MC74ACT540	–	20	N	DW
	CMOS	MC74AC541	–	20	N	DW
	CMOS	MC74ACT541	–	20	N	DW
	CMOS	MC74AC240	–	20	N	DW
	CMOS	MC74ACT240	–	20	N	DW
CMOS	MC74ACT241	–	20	N	DW	
Octal Bus Transceiver	TTL	SN54LS245	SN74LS245	20	N,J	DW
	TTL	SN54LS623	SN74LS623	20	N,J	DW
Octal Bus Transceiver, With 3-State Outputs	TTL	MC74F623	–	20	N	DW
Octal Bus Transceiver/Inverting With 3-State Outputs	TTL	SN54LS640	SN74LS640	20	N,J	DW
	TTL	MC74F620	–	20	N	DW
	TTL	MC74F640	–	20	N	DW
Octal Bus Transceiver/Non-Inverting With 3-State Outputs	TTL	SN54LS645	SN74LS645	20	N,J	DW
Octal Bus Transceiver/Register With 3-State Outputs Non-Inverting	CMOS	MC74AC652	–	24	N	DW
	CMOS	MC74ACT652	–	24	N	DW
Octal Registered Transceiver Inverting, With 3-State Outputs	TTL	MC74F544	–	24	N	DW
Octal Registered Transceiver Non-Inverting, With 3-State Outputs	TTL	MC74F543	–	24	N	DW
Octal Transceiver/Register With 3-State Outputs Non-Inverting	CMOS	MC74AC646	–	24	N	DW
	CMOS	MC74ACT646	–	24	N	DW
Octal Transceiver/Register With 3-State Outputs Inverting	CMOS	MC74AC648	–	24	N	DW
	CMOS	MC74ACT648	–	24	N	DW
Octal Transceiver/Register, With 3-State Outputs	TTL	MC74F646	–	24	N	DW
Octal With 3-State Non-Inverting Buffer/Line Driver/Line Receiver	CMOS	MC54HC241A	MC74HC241A	20	N,J	DW
Octal With 3-State Non-Inverting Buffer/Line Driver/Line Receiver With LSTTL Compatible Inputs	CMOS	MC54HCT241A	MC74HCT241A	20	N,J	DW
	CMOS	MC54HCT244A	MC74HCT244A	20	N,J	DW, SD,DT
Octal With 3-State Outputs Inverting Buffer/Line Driver/Line Receiver	CMOS	MC54HC240A	MC74HC240A	20	N,J	DW, DT
	CMOS	MC54HC540A	MC74HC540A	20	N,J	DW
Octal With 3-State Outputs Inverting Buffer/Line Driver/Line Receiver With LSTTL Compatible Inputs	CMOS	MC74HCT240A	–	20	N	DW, SD,DT
Octal With 3-State Outputs Inverting Bus Transceiver	CMOS	MC54HC640A	MC74HC640A	20	N,J	DW
Octal With 3-State Outputs Non-Inverting Buffer/Line Driver/Line Receiver	CMOS	MC54HC541A	MC74HC541A	20	N,J	DW
Octal With 3-State Outputs Non-Inverting Buffer/Line Driver/Line Receiver With LSTTL Compatible Inputs	CMOS	MC74HCT541A	–	20	N	DW

## Selection by Function

Description	Tech.	Device(s)		Pins	DIP	SM
<b>BUS INTERFACE</b>						
Octal With 3-State Outputs Non-Inverting Buffer/Line Driver/Line Receiver	CMOS	MC54HC244A	MC74HC244A	20	N,J	DW, SD,DT
Octal With 3-State Outputs Non-Inverting Bus Transceiver	CMOS	MC54HC245A	MC74HC245A	20	N,J	DW
Octal With 3-State Outputs Non-Inverting Bus Transceiver & D Flip-Flop	CMOS	MC54HC646	MC74HC646	24	N,J	DW
Quad Buffers With 3-State Outputs	TTL	SN54LS125A	SN74LS125A	14	N,J	D
Quad 3-State Non-Inverting Buffers	CMOS	MC74HC125A	–	14	N	D
	CMOS	MC74HC126A	–	14	N	D
Quad Buffer With 3-State Outputs	CMOS	MC74AC125	–	14	N	D
	CMOS	MC74ACT125	–	14	N	D
	CMOS	MC74AC126	–	14	N	D
	CMOS	MC74ACT126	–	14	N	D
	TTL	MC74F125	–	14	N	D
	TTL	MC74F126	–	14	N	D
	TTL	SN54LS126A	SN74LS126A	14	N,J	D
Quad Bus Driver	ECL	MC10192	–	16	P,L	FN
Quad Bus Driver/Receiver With 2-to-1 Output Multiplexer (25Ω)	ECL	MC10H330	–	24	P,L	FN
Quad Bus Driver/Receiver With Transmit & Receiver Latches (25Ω)	ECL	MC10H334	–	20	P,L	FN
Quad Bus Transceiver/Inverting With 3-State Outputs	TTL	SN54LS242	SN74LS242	14	N,J	D
Quad Bus Transceiver/Non-Inverting With 3-State Outputs	TTL	SN54LS243	SN74LS243	14	N,J	D
Quad Bus Transceivers With 3-State Outputs	TTL	MC74F242	–	14	N	D
	TTL	MC74F243	–	14	N	D
Quad With 3-State Outputs Inverting Bus Transceiver	CMOS	MC74HC242	–	14	N	
Triple 3-Input Bus Driver With Enable (25Ω)	ECL	MC10H423	–	16	P,L	FN
Triple 4-3-3 Input Bus Driver (25Ω)	ECL	MC10H123	–	16	P,L	FN
	ECL	MC10123	–	16	P,L	FN
<b>CBM</b>						
CBM – Carrier Band Modem	SXLG	MC68194	–	52		*FJ
<b>CLOCK DISTRIBUTION CHIPS</b>						
1:4 Clock Distribution Chip	ECL	MC10EL15	MC100EL15	16		D
1:5 Clock Distribution Chip	ECL	MC100LVEL14	MC100EL14	20		DW
1:6 Differential Clock Distribution Chip	ECL	MC10E211	MC100E211	28		FN
Low Voltage 1:12 Clock Distribution Chip	SXLG	MPC948	–	32		FA
Low Voltage 1:9 Clock Distribution Chip	SXLG	MPC947	–	32		FA
Low Voltage 1:9 ECL/PECL Clock Distribution Chip	ECL	MC100LVE111	–	28		FN
<b>CLOCK DRIVERS</b>						
1:2 Differential Clock Driver	ECL	MC10EL11	MC100EL11	8		D
1:6 PCI Clock Generator/Fanout Buffer	CMOS	MPC903	–	16		D
	CMOS	MPC904	–	16		D
	CMOS	MPC905	–	16		D
1:9 Differential Clock Driver With Low Skew, Enable, Vbb	ECL	MC10E111	MC100E111	28		FN
1:9 Differential ECL/PECL RAMBus Clock Buffer	ECL	MC10E411	–	28		FN
1:9 TTL/TTL Clock Distribution Chip	ECL	MC10H645	–	28		FN
3.3/5.0V Fully Integrated PLL Clock Driver	CMOS	MPC974	–	52		FA
50 MHz Low Skew CMOS PLL Clock Driver With μP Power Down	CMOS	MC88920	–	20		DW
66 MHz Low Skew CMOS PLL Clock Driver With μP Power-Down/Power-Up Feature	CMOS	MC88921	–	20		DW

## Selection by Function

Description	Tech.	Device(s)		Pins	DIP	SM
<b>CLOCK DRIVERS</b>						
68030/040 PECL/TTL Clock Driver	ECL	MC10H640	MC100H640	28		FN
	ECL	MC10H642	MC100H642	28		FN
	ECL	MC10H644	MC100H644	20		FN
Clock Driver Quad D-Type Flip-Flop w/ Matched Propagation Delays	TTL	MC74F1803	–	14	N	D
	TTL	MC74F803	–	14	N	D
CMOS PLL Clock Driver Programmable Frequency, Low Skew, High Fan-Out	CMOS	MC88PL117	–	52		FN
Dual 3.3V PLL Clock Generator	CMOS	MPC980	–	52		FA
Dual Supply ECL/TTL 1:8 Clock Driver	ECL	MC10H643	MC100H643	28		FN
High Frequency PLL Clock Generator	ECL	MC12429	–	28		FN
	ECL	MC12439	–	28		FN
Low Skew CMOS Clock Driver	CMOS	MC88913	–	14	N	D
Low Skew CMOS Clock Driver With Reset	CMOS	MC88914	–	14	N	D
Low Skew CMOS PLL 68060 Clock Driver	CMOS	MC88LV926	–	20		DW
Low Skew CMOS PLL Clock Driver	CMOS	MC88915*55	–	28		FN
	CMOS	MC88915*70	–	28		FN
Low Skew CMOS PLL Clock Driver With Processor Reset	CMOS	MC88916*70	–	20		DW
	CMOS	MC88916*80	–	20		DW
Low Skew CMOS PLL Clock Driver	160 MHz Version	CMOS	MC88915T*160	–	28	FN
	133 MHz Version	CMOS	MC88915T*133	–	28	FN
	100 MHz Version	CMOS	MC88915T*100	–	28	FN
	70 MHz Version	CMOS	MC88915T*70	–	28	FN
	55 MHz Version	CMOS	MC88915T*55	–	28	FN
Low Voltage 1:10 CMOS Clock Driver	CMOS	MPC946	–	32		FA
Low Voltage 1:15 Differential +/-1/2 ECL/PECL Clock Driver	ECL	MC100LVE222	–	52		FA
Low Voltage 1:15 PECL to CMOS Clock Driver	CMOS	MPC949	–	52		FA
Low Voltage 1:9 Differential ECL/HSTL to HSTL Clock Driver	CMOS	MPC911	–	28		FN
Low Voltage PECL PLL Clock Driver	CMOS	MPC992	–	32		FA
Low Voltage PLL Clock Driver	CMOS	MPC930	MPC931	32		FA
Low Voltage PLL Clock Driver	CMOS	MPC950	MPC951	32		FA
Low Voltage PLL Clock Driver	CMOS	MPC956	–	32		FA
Low Voltage PLL Clock Driver	CMOS	MPC970	–	52		FA
Low Voltage Wide Fanout PLL Clock Driver	CMOS	MPC952	–	32		FA
Multiple Output Clock Synthesizer	CMOS	MPC9159-410	–	28		DW
PECL/TTL to TTL 1: 8 Clock Distribution Chip	ECL	MC10H646	MC100H646	28		FN
Single Supply PECL/TTL 1:9 Clock Distribution Chip	ECL	MC10H641	MC100H641	28		FN
+2, +4/6 Clock Generation Chip (3.3V)	ECL	MC100LVEL38	MC100EL38	20		DW
+2/4, +4/6 Clock Generation Chip	ECL	MC100LVEL39	MC100EL39	20		DW
+2,4,8 Differential Clock Driver	ECL	MC10EL34	MC100EL34	16		D
<b>COAX CABLE DRIVERS</b>						
Fibre Channel Coaxial Cable Driver and Loop Resiliency Circuit	SDX	MC10SX1189	–	16		D
300 MBit/s LED Driver for FDDI and Fibre Channel	SDX	MC10SX1130	–	16		D
<b>COMPARATORS</b>						
4-Bit Magnitude Comparator	TTL	MC74F85	–	16	N	D
	CMOS	MC74HC85	–	16	N	DT
	TTL	SN54LS85	SN74LS85	16	N,J	D
	CMOS	MC14585B	–	16	P,L	D

## Selection by Function

Description	Tech.	Device(s)		Pins	DIP	SM
<b>COMPARATORS</b>						
5–Bit Magnitude Comparator	ECL	MC10H166	–	16	P,L	FN
	ECL	MC10166	–	16	P,L	FN
8–Bit Equality Comparator	CMOS	MC54HC688	MC74HC688	20	N,J	DW
8–Bit Identity Comparator	CMOS	MC74ACT521	–	20	N	
	TTL	MC74F521	–	20	N	DW
8–Bit Magnitude Comparator	TTL	SN54LS682	SN74LS682	20	N,J	DW
	TTL	SN54LS684	SN74LS684	20	N,J	DW
	TTL	SN54LS688	SN74LS688	20	N,J	DW
9–Bit Magnitude Comparator	ECL	MC10E166	MC100E166	28		FN
Dual Analog Comparator With Latch	ECL	MC10E1651	–	16,20	L	FN
Dual Analog Comparator With Latch (Hi–Perf MC1651)	ECL	MC10E1652	–	16,20	L	FN
<b>CONVERTERS</b>						
4–Bit Parallel to Serial Converter	ECL	MC10E446	MC100E446	28		FN
4–Bit Serial to Parallel Converter	ECL	MC10E445	MC100E445	28		FN
Dual A/D Converter	ECL	MC1650	–	16	L	
	ECL	MC1651	–	16	L	
<b>COUNTERS</b>						
12–Bit Binary Counter	CMOS	MC14040B	–	16	P,L	D
12–Stage Binary Ripple Counter	CMOS	MC54HC4040A	MC74HC4040A	16	N,J	D,DT
	CMOS	MC74AC4040	–	16	N	D
14–Bit Binary Counter	CMOS	MC14020B	–	16	P,L	D
14–Bit Binary Counter and Oscillator	CMOS	MC14060B	–	16	P,L	D
14–Stage Binary Ripple Counter	CMOS	MC74HC4020A	–	16	N	D,DT
	CMOS	MC74AC4020	–	16	N	D
14–Stage Binary Ripple Counter With Oscillator	CMOS	MC54HC4060	MC74HC4060	16	N,J	DT
	CMOS	MC54HC4060A	MC74HC4060A	16	N,J	D,DT
3–Digit BCD Counter	CMOS	MC14553B	–	16	P	DW
4–Bit BCD Decade Counter, Asynchronous Reset	TTL	SN54LS160A	SN74LS160A	16	N,J	D
	TTL	SN54LS162A	SN74LS162A	16	N,J	D
4–Bit Bidirectional Binary Counter, With 3–State Outputs	TTL	MC74F569	–	20	N	DW
4–Bit Bidirectional Decade Counter, With 3–State Outputs	TTL	MC74F568	–	20	N	DW
4–Bit Binary Counter	TTL	SN54LS93	SN74LS93	14	N,J	D
	TTL	SN54LS293	SN74LS293	14	N,J	D
	ECL	MC10H16	–	16	P,L	FN
4–Bit Binary Counter, Synchronous Presettable	CMOS	MC14161B	–	16	P	D
	CMOS	MC14163B	–	16	P	D
4–Bit Binary Counter, Synchronous Reset	TTL	SN54LS161A	SN74LS161A	16	N,J	D
	TTL	SN54LS163A	SN74LS163A	16	N,J	D
4–Bit Up/Down Counter With 3–State Outputs	TTL	SN54LS569A	SN74LS569A	20	N,J	DW
4–Stage Presettable Ripple Counters	TTL	SN54LS196	SN74LS196	14	N,J	D
	TTL	SN54LS197	SN74LS197	14	N,J	D
4–Stage Synchronous Bidirectional Counter	TTL	MC74F168	–	16	N	D
	TTL	MC74F169	–	16	N	D
5 Cascaded BCD Counters	CMOS	MC14534B	–	24	P,L	DW
6–Bit Universal Counter, (Lookahead Carry)	ECL	MC10E136	MC100E136	28		FN
7–Stage Ripple Counter	CMOS	MC14024B	–	14	P,L	D
8–Bit Bidirectional Binary Counter	TTL	MC74F269	–	24	N	DW

## Selection by Function

Description	Tech.	Device(s)		Pins	DIP	SM
<b>COUNTERS</b>						
8–Bit Bidirectional Binary Counter, With 3–State Outputs	TTL	MC74F579	–	20	N	DW
	TTL	MC74F779	–	16	N	D
8–Bit Ripple Counter	ECL	MC10E137	MC100E137	28		FN
8–Bit Synchronous Binary Up Counter	ECL	MC10E016	MC100E016	28		FN
BCD Decade Counter, Synchronous Presettable	TTL	MC74F160A	–	16	N	D
	TTL	MC74F162A	–	16	N	D
BCD Decade Synchronous Bidirectional Counter	TTL	SN54LS168	SN74LS168	16	N,J	D
Bi–Quinary Counter	ECL	MC10138	–	16	P,L	FN
Binary Counter	ECL	MC10154	–	16	P,L	
	ECL	MC10178	–	16	P,L	FN
Binary Counter, Synchronous Presettable, 4–Bit	TTL	MC74F161A	–	16	N	D
	TTL	MC74F163A	–	16	N	D
Counter Control Logic	ECL	MC12014	–	16	P,L	
Decade Counter	TTL	SN54LS90	SN74LS90	14	N,J	D
	TTL	SN54LS290	SN74LS290	14	N,J	D
	CMOS	MC14017B	–	16	P,L	D
	CMOS	MC74HC4017	–	16	N	D
Divide By 12 Counter	TTL	SN54LS92	SN74LS92	14	N,J	D
Dual 4–Stage Binary Counter	TTL	SN54LS393	SN74LS393	16	N,J	D
Dual 4–Stage Binary Ripple Counter	CMOS	MC54HC393	MC74HC393	14	N,J	D
Dual 4–Stage Binary Ripple Counter W +2, +5 Sections	CMOS	MC54HC390	MC74HC390	16	N,J	D
Dual BCD Up Counter	CMOS	MC14518B	–	16	P,L	DW
Dual Binary Up Counter	CMOS	MC14520B	–	16	P,L	DW
Dual Decade Counter	TTL	SN54LS390	SN74LS390	16	N,J	D
	TTL	SN54LS490	SN74LS490	16	N,J	D
Industrial Time Base Generator	CMOS	MC14566B	–	16	P	D
Modulo 16 Binary Synchronous Bidirectional Counter	TTL	SN54LS169	SN74LS169	16	N,J	D
Octal Counter	CMOS	MC14022B	–	16	P,L	D
Phase Comparator and Programmable Counter	CMOS	MC14568B	–	16	P,L	D
Presettable 4–Bit BCD Down Counter	CMOS	MC14522B	–	16	P	DW
Presettable 4–Bit Binary Down Counter	CMOS	MC14526B	–	16	P,L	DW
Presettable 4–Bit Binary Up/Down Counter	TTL	SN54LS191	SN74LS191	16	N,J	D
	TTL	SN54LS193	SN74LS193	16	N,J	D
Presettable BCD Up/Down Counter	CMOS	MC14510B	–	16	P	D
Presettable BCD/Decade Up/Down Counter	TTL	SN54LS190	SN74LS190	16	N,J	D
	TTL	SN54LS192	SN74LS192	16	N,J	D
Presettable Binary Up/Down Counter	CMOS	MC14516B	–	16	P,L	D
Presettable Binary/BCD Up/Down Counter	CMOS	MC14029B	–	16	P,L	D
Presettable Counter	CMOS	MC54HC160	MC74HC160	16	N,J	D
	CMOS	MC54HC161A	MC74HC161A	16	N,J	D
	CMOS	MC54HCT161A	MC74HCT161A	16	N,J	D
	CMOS	MC54HC162	MC74HC162	16	N,J	D
	CMOS	MC54HC163A	MC74HC163	16	N,J	D
	CMOS	MC54HCT163A	MC74HCT163A	16	N,J	D
Presettable Divide–by–N Counter	CMOS	MC14018B	–	16	P	D
Programmable Dual Binary/BCD Counter	CMOS	MC14569B	–	16	P,L	DW

## Selection by Function

Description	Tech.	Device(s)		Pins	DIP	SM
<b>COUNTERS</b>						
Programmable Modulo-N Counters (N=0-9)	ECL	MC4016	-	16	P,L	
	ECL	MC4018	-	16	P,L	
	ECL	MC4316	-	16	P,L	
Synchronous 4-Bit Up/Down Counter	TTL	SN54LS669	SN74LS669	16	N,J	D
Synchronous Presettable Binary Counter	CMOS	MC74AC161	-	16	N	D
	CMOS	MC74ACT161	-	16	N	D
Synchronous Presettable Binary Counter	CMOS	MC74AC163	-	16	N	D
	CMOS	MC74ACT163	-	16	N	D
	CMOS	MC74AC160	-	16	N	D
Synchronous Presettable Binary-Coded-Decimal Decade Counter	CMOS	MC74AC160	-	16	N	D
	CMOS	MC74ACT160	-	16	N	D
	CMOS	MC74AC162	-	16	N	D
	CMOS	MC74ACT162	-	16	N	D
Universal Decade Counter	ECL	MC10137	-	16	P,L	
Universal Hexadecimal Counter	ECL	MC10H136	-	16	P,L	FN
	ECL	MC10136	-	16	P,L	FN
Up/Down Counter With Preset and Ripple Clock	CMOS	MC74AC190	-	16	N	D
<b>DECODER/DEMULPLEXERS</b>						
1-of-10 Decoder	CMOS	MC74HC42	-	16	N	D
	TTL	SN54LS42	SN74LS42	16	N,J	D
1-of-10 Decoder/Driver Open-Collector	TTL	SN54LS145	SN74LS145	16	N,J	D
1-of-10 Decoder, With 3-State Outputs	TTL	MC74F537	-	20	N	DW
1-of-16 Decoder/Demultiplexer	CMOS	MC54HC154	MC74HC154	24	N,J	DW
1-of-16 Decoder/Demultiplexer With Address Latch	CMOS	MC74HC4514	-	24	N	DW
1-of-4 Decoder, With 3-State Outputs	TTL	MC74F539	-	20	N	DW
1-of-8 Decoder, With 3-State Outputs	TTL	MC74F538	-	20	N	DW
1-of-8 Decoder/Demultiplexer	CMOS	MC74AC138	-	16	N	D
	CMOS	MC74ACT138	-	16	N	D
	TTL	MC74F138	-	16	N	D
	CMOS	MC54HC138A	MC74HC138A	16	N,J	D
	CMOS	MC74HCT138A	-	16	N	D,DT
	TTL	SN54LS138	SN74LS138	16	N,J	D
1-of-8 Decoder/Demultiplexer With Address Latch	CMOS	MC74HC137	-	16	N	D
	CMOS	MC74HC237	-	16	N	D
3-Line to 8-Line Decoders/Demultiplexers With Address Latches	TTL	SN54LS137	SN74LS137	16	N,J	D
4-Bit Transparent Latch/4-to-16 Line Decoder (High)	CMOS	MC14514B	-	24	P,L	DW
4-Bit Transparent Latch/4-to-16 Line Decoder (Low)	CMOS	MC14515B	-	24	P,L	DW
8-Bit Addressable Latch/1-of-8 Decoder	CMOS	MC54HC259	MC74HC259	16	N,J	D
BCD-to-Decimal Decoder/Binary-to-Octal Decoder	CMOS	MC14028B	-	16	P,L	D
Binary to 1-4 Decoder (Low)	ECL	MC10171	-	16	P,L	FN
Binary to 1-8 Decoder, (High)	ECL	MC10H162	-	16	P,L	FN
	ECL	MC10162	-	16	P,L	FN
Binary to 1-8 Decoder, (Low)	ECL	MC10H161	-	16	P,L	FN
	ECL	MC10161	-	16	P,L	FN
Dual 1-of-4 Decoder	TTL	SN54LS155	SN74LS155	16	N,J	D
Dual 1-of-4 Decoder Open-Collector	TTL	SN54LS156	SN74LS156	16	N,J	D



## Selection by Function

Description	Tech.	Device(s)	Pins	DIP	SM
<b>DECODER/DEMULPLEXERS</b>					
Dual 1-of-4 Decoder/Demultiplexer	CMOS	MC74AC139	–	16	N, D
	CMOS	MC74ACT139	–	16	N, D
	TTL	MC74F139	–	16	N, D
Dual 1-of-4 Decoder/Demultiplexer	CMOS	MC54HC139A	MC74HC139A	16	N, J, D
	TTL	SN54LS139	SN74LS139	16	N, J, D
Dual Binary to 1-4 Decoder (High)	ECL	MC10H172	–	16	P, L, FN
	ECL	MC10172	–	16	P, L, FN
Dual Binary to 1-4 Decoder (Low)	ECL	MC10H171	–	16	P, L, FN
Dual Binary to 1-of-4 Decoder (Active High Outputs)	CMOS	MC14555B	–	16	P, D
Dual Binary to 1-of-4 Decoder (Active Low Outputs)	CMOS	MC14556B	–	16	P, D
Low-Voltage CMOS 1-of-8 Decoder/Demultiplexer With 5V Tolerant Inputs and Outputs	CMOS	MC74LCX138	–	16	D, DT
Low-Voltage Quiet CMOS 1-of-8 Decoder/Demultiplexer	CMOS	MC74LVQ138	–	16	D, M, SD, DT
<b>DETECTORS</b>					
Analog Mixer	ECL	MC12002	–	14	P, L
Phase-Frequency Detector	ECL	MC4044	–	14	P, L, D
	ECL	MC4344	–	14	P, L
	ECL	MC12040	–	14	P, L, FN
	ECL	MCH12140	MCK12140	8	D
<b>DISPLAY DECODE DRIVERS</b>					
BCD-to-Seven Segment Decoder	TTL	SN54LS48	SN74LS48	16	N, J, D
	CMOS	MC14558B	–	16	P, L, D
BCD-to-Seven Segment Decoder/Driver	TTL	SN54LS47	SN74LS47	16	N, J, D
	TTL	SN54LS247	SN74LS247	16	N, J, D
	TTL	SN54LS248	SN74LS248	16	N, J, D
	TTL	SN54LS249	SN74LS249	16	N, J, D
BCD-to-Seven Segment Latch/Decoder/Display Driver	CMOS	MC74HC4511	–	16	N, D
BCD-to-Seven Segment Latch/Decoder/Driver	CMOS	MC14511B	–	16	P, L, D, DW
BCD-to-Seven Segment Latch/Decoder/Driver for Liquid Crystals	CMOS	MC14543B	–	16	P, L, D
BCD-to-Seven Segment Latch/Decoder/Driver With Ripple Blanking	CMOS	MC14544B	–	18	P, L
	CMOS	MC14513B	–	18	P
High Current BCD-to-Seven Segment Decoder/Driver	CMOS	MC14547B	–	16	P, L, DW
<b>DIVIDERS</b>					
÷ 2 Divider	ECL	MC10EL32	MC100EL32	8	D
	ECL	MC100LVEL32	–	8	D
÷ 4 Divider	ECL	MC10EL33	MC100EL33	8	D
	ECL	MC100LVEL33	–	8	D
<b>DRIVER</b>					
Coaxial Cable Driver	ECL	MC10EL89	–	8	D
300MBit/s LED Driver for FDDI and Fibre Channel	ECL	MC10SX1130	–	16	D
<b>EDACs</b>					
Error Detection-Correction Circuit (IBM Code)	ECL	MC10163	–	16	P, L
Error Detection-Correction Circuit (Motorola Code)	ECL	MC10193	–	16	P, L
<b>ENCODERS</b>					
10-Line to 4-Line Priority Encoder	TTL	SN54LS147	SN74LS147	16	N, J, D
8-Bit Priority Encoder	CMOS	MC14532B	–	16	P, L, D

## Selection by Function

Description	Tech.	Device(s)		Pins	DIP	SM
<b>ENCODERS</b>						
8-Input Priority Encoder	TTL	SN54LS348	SN74LS348	16	N,J	D
	ECL	MC10H165	–	16	P,L	FN
	ECL	MC10165	–	16	P,L	FN
8-Input Priority Encoder (Glitchless)	TTL	SN54LS848	SN74LS848	16	N,J	D
8-Line to 3-Line Priority Encoder	TTL	MC74F148	–	16	N	D
	TTL	SN54LS148	SN74LS148	16	N,J	D
	TTL	SN54LS748	SN74LS748	16	N,J	D
Decimal-to-BCD Encoder	CMOS	MC74HC147	–	16	N	D
<b>ENCODER/DECODERS</b>						
CMI Encoder/Decoder	ECL	MC100SX1230	–	28		FN
<b>EXPANDERS</b>						
Dual 4-Input Expander	HTL	MC669	–	14	P,L	
Expandable Dual 4-Input Gate (Active Pullup)	HTL	MC660	–	14	P,L	
Expandable Dual 4-Input Gate (Passive Pullup)	HTL	MC661	–	14	P,L	
Expandable Dual 4-Input Line Driver	HTL	MC662	–	14	P,L	
Expandable Dual Power Gate	DTL	MC844	–	14	P,L	
	DTL	MC944	–	14	P,L	
<b>FIELD PROGRAMMABLE GATE ARRAY</b>						
14,200-Gate Programmable Array With Up to 160 User I/Os	CMOS	MPA1064	–	160, 224		DH, KE
22,000-Gate Programmable Array With Up to 200 User I/Os	CMOS	MPA1100	–	229		HV
3,500-Gate Programmable Array With Up to 80 User I/Os	CMOS	MPA1016	–	84		FN
8,000-Gate Programmable Array With Up to 120 User I/Os	CMOS	MPA1036	–	84, 160, 181		FN, DH, HI
<b>FLIP-FLOPS</b>						
3-Bit Differential Flip-Flop	ECL	MC10E431	MC100E431	28		FN
4-Bit D Flip-Flop Individual Clock, Reset Differential Output	ECL	MC10E131	MC100E131	28		FN
4-Bit D Flip-Flop With Enable	TTL	SN54LS379	SN74LS379	16	N,J	D
4-Bit D-Type Register With With 3-State Outputs	TTL	SN54LS173A	SN74LS173A	16	N,J	D
5-Bit Differential Register	ECL	MC10E452	MC100E452	28		FN
6-Bit 2:1 Mux-Register With Common Clock, Asynchronous Master Reset Single Ended	ECL	MC10E167	MC100E167	28		FN
6-Bit D Register With Common Clock, Asynchronous Master Reset, Differential Outputs	ECL	MC10E151	MC100E151	28		FN
6-Bit D Register, With Differential Inputs, (Data & Clock) , VBB, Common Reset	ECL	MC10E451	MC100E451	28		FN
	CMOS	MC74AC378	–	16	N	D
6-Bit Parallel D Register With Enable	CMOS	MC74ACT378	–	16	N	D
9-Bit Hold Register, 700MHz, With Asynchronous Master Reset	ECL	MC10E143	MC100E143	28		FN
Clocked Flip-Flop	DTL	MC845	–	14	P,L	
	DTL	MC945	–	14	P,L	
D Flip-Flop With Set & Reset	ECL	MC10EL31	MC100EL31	8		D
Differential Clock D Flip-Flop	ECL	MC10EL51	MC100EL51	8		D
	ECL	MC100LVEL51	–	8		D
Differential Data & Clock D Flip-Flop	ECL	MC10EL52	MC100EL52	8		D
Dual D Flip-Flop	CMOS	MC74AC74	–	14	N	D
	CMOS	MC74ACT74	–	14	N	D
	CMOS	MC14013B	–	14	P,L	D

## Selection by Function

Description	Tech.	Device(s)		Pins	DIP	SM
<b>FLIP-FLOPS</b>						
Dual D Flip-Flop With Set and Reset	CMOS	MC54HC74A	MC74HC74A	14	N,J	D,DT
Dual D Flip-Flop With Set and Reset With LSTTL Compatible Inputs	CMOS	MC74HCT74A	–	14	N	D
Dual D-Type Positive Edge-Triggered Flip-Flop	TTL	MC74F74	–	14	N	D
	TTL	SN54LS74A	SN74LS74A	16	N,J	D
Dual Differential Data and Clock D Flip-Flop With Set and Reset	ECL	MC100LVEL29	MC100EL29	20		DW
Dual J-K Negative Edge-Triggered Flip-Flop	TTL	SN54LS112A	SN74LS112A	16	N,J	D
	TTL	SN54LS113A	SN74LS113A	14	N,J	D
	TTL	SN54LS114A	SN74LS114A	14	N,J	D
Dual J-K Positive Edge-Triggered Flip-Flop	TTL	SN54LS109A	SN74LS109A	16	N,J	D
Dual J-K Flip-Flop	HTL	MC663	–	14	P,L	
	TTL	SN54LS107A	SN74LS107A	14	N,J	D
Dual J-K Flip-Flop (Common Clock and CD Separate SD)	DTL	MC952	–	14	P,L	
Dual J-K Flip-Flop (Separate Clock and SD, No CD)	DTL	MC953	–	14	P,L	
Dual J-K Flip-Flop Negative Edge Trigger	CMOS	MC74AC112	–	16	N	D
	CMOS	MC74ACT112	–	16	N	D
Dual J-K Flip-Flop Negative Edge Trigger	CMOS	MC74AC113	–	14	N	D
	CMOS	MC74ACT113	–	14	N	D
Dual J-K Flip-Flop With Set and Clear	TTL	SN54LS76A	SN74LS76A	16	N,J	D
Dual J-K Flip-Flop With Set and Reset	CMOS	MC74HC112	–	16	N	D,DT
Dual J-K Flip-Flop	CMOS	MC14027B	–	16	P,L	D
Dual J-K Flip-Flop With Reset	CMOS	MC74HC73	–	14	N	D
	CMOS	MC74HC107	–	14	N	D
Dual J-K Flip-Flop With Set and Reset	CMOS	MC74HC76	–	16	N	D
Dual J-K Master-Slave Flip-Flop	ECL	MC10135	–	16	P,L	FN
	ECL	MC10H135	–	16	P,L	FN
Dual J-K Negative Edge-Triggered Flip-Flop	TTL	MC74F112	–	16	N	D
	TTL	SN54LS73A	SN74LS73A	14	N,J	D
Dual J-K Positive Edge-Triggered Flip-Flop With Set & Clear	CMOS	MC74AC109	–	16	N	D
	CMOS	MC74ACT109	–	16	N	D
Dual J-K Flip-Flop With Set and Reset	CMOS	MC74HC109	–	16	N	D
Dual J-K Positive Edge-Triggered Flip-Flop	TTL	MC74F109	–	16	N	D
Dual Type-D Master-Slave Flip-Flop	ECL	MC10131	–	16	P,L	FN
	ECL	MC10H131	–	16	P,L	FN
Hex D Flip-Flop	TTL	SN54LS174	SN74LS174	16	N,J	D
	CMOS	MC14174B	–	16	P,L	D
Hex D Flip-Flop With Enable	TTL	SN54LS378	SN74LS378	16	N,J	D
Hex D Flip-Flop With Master Reset	CMOS	MC74AC174	–	16	N	D
	TTL	MC74F174	–	16	N	D
	CMOS	MC74ACT174	–	16	N	D
Hex D Flip-Flop With Common Clock & Reset	CMOS	MC54HC174A	MC74HC174A	16	N,J	D
	CMOS	MC74HCT174A	–	16	N	D
Hex D Master-Slave Flip-Flop	ECL	MC10H176	–	16	P,L	FN
	ECL	MC10176	–	16	P,L	FN
Hex D Master-Slave Flip-Flop With Reset	ECL	MC10H186	–	16	P,L	FN
	ECL	MC10186	–	16	P,L	FN
High Speed Dual D Master-Slave Flip-Flop	ECL	MC10231	–	16	P,L	FN
J-K Flip-Flop	ECL	MC10EL35	MC100EL35	8		D

## Selection by Function

Description	Tech.	Device(s)		Pins	DIP	SM
<b>FLIP-FLOPS</b>						
Low-Voltage CMOS Octal D-Type Flip-Flop With Set and Reset, 3-State, Non-Inverting With 5V Tolerant Inputs	CMOS	MC74LCX74	–	14		D,DT
Low-Voltage CMOS 16-Bit D-Type Flip-Flop, 3-State, Non-Inverting With 5V Tolerant Inputs and Outputs	CMOS	MC74LCX16374	–	20		DW,M,DT
Low-Voltage CMOS Octal D-Type Flip-Flop, 3-State, Non-Inverting With 5V Tolerant Inputs and Outputs	CMOS	MC74LCX374	–	20		DW,M,DT
Low-Voltage CMOS Octal D-Type Flip-Flop Flow Through Pinout, 3-State, Non-Inverting With 5V Tolerant Inputs and Outputs	CMOS	MC74LCX574	–	20		DW,M,DT
Low Voltage D Flip-Flop With Set & Reset	ECL	MC100LVEL31	–	8		D
Low-Voltage Quiet CMOS Octal D-Type Flip-Flop	CMOS	MC74LVQ374	–	20		DW,M,SD,DT
Low-Voltage Quiet CMOS Octal D-Type Flip-Flop Flow Through Pinout	CMOS	MC74LVQ574	–	20		DW,M,SD,DT
Master-Slave Flip-Flop	ECL	MC1670	–	16	L	
Master-Slave R-S Flip-Flop	HTL	MC664	–	14	P,L	
Octal 3-State Inverting D Flip-Flop	CMOS	MC54HC534A	MC74HC534A	20	N,J	DW
Octal 3-State Non-Inverting D Flip-Flop With LSTTL Compatible Inputs	CMOS	MC54HCT374A	MC74HCT374A	20	N,J	DW
Octal D Flip Flop, With 3-State Outputs	TTL	MC74F374	–	20	N	DW
Octal D Flip-Flop	CMOS	MC74AC273	–	20	N	DW
	CMOS	MC74ACT273	–	20	N	DW
Octal D Flip-Flop With 3-State Outputs/Broadside Pinout, F374	TTL	MC74F574	–	20	N	DW
Octal D Flip-Flop With Clear	TTL	SN54LS273	SN74LS273	20	N,J	DW
	CMOS	MC74AC377	–	20	N	DW
Octal D Flip-Flop With Clock Enable	CMOS	MC74ACT377	–	20	N	DW
	CMOS	MC74ACT377	–	20	N	DW
Octal D Flip-Flop With Common Clock & Reset	CMOS	MC54HC273A	MC74HC273A	20	N,J	DW,DT
Octal D Flip-Flop With Common Clock and Reset With LSTTL Compatible Inputs	CMOS	MC74HCT273A	–	20	N	DW
Octal D Flip-Flop With Enable	TTL	MC74F377	–	20	N	DW
Octal D Flip-Flop With Enable/ Non-Inverting	TTL	SN54LS377	SN74LS377	20	N,J	DW
Octal D Type Flip-Flop With 3-State Outputs	CMOS	MC74AC374	–	20	N	DW
	CMOS	MC74ACT374	–	20	N	DW
	TTL	MC74F534	–	20	N	DW
	TTL	SN54LS374	SN74LS374	20	N,J	DW
	CMOS	MC74AC534	–	20	N	DW
	CMOS	MC74ACT534	–	20	N	DW
Octal D-Type Latch With 3-State Outputs	CMOS	MC74AC564	–	20	N	DW
	CMOS	MC74ACT564	–	20	N	DW
	CMOS	MC74AC574	–	20	N	DW
	CMOS	MC74ACT574	–	20	N	DW
Octal With 3-State Outputs Inverting D Flip-Flop	CMOS	MC74HC564A	–	20	N	DW
Octal With 3-State Outputs Non-Inverting D Flip-Flop	CMOS	MC54HC374A	MC74HC374A	20	N,J	DW,SD,DT
	CMOS	MC54HC574A	MC74HC574A	20	N,J	DW
Octal With 3-State Outputs Non-Inverting D Flip-Flop With LSTTL Compatible Inputs	CMOS	MC54HCT574A	MC74HCT574A	20	N,J	DW
Quad D Flip-Flop	CMOS	MC74AC175	–	16	N	D
	CMOS	MC74ACT175	–	16	N	D
	TTL	MC74F175	–	16	N	D

## Selection by Function

Description	Tech.	Device(s)		Pins	DIP	SM
<b>FLIP-FLOPS</b>						
Quad D Flip-Flop	TTL	SN54LS175	SN74LS175	16	N,J	D
	CMOS	MC14175B	–	16	P,L	D
Quad D Flip-Flop With Common Clock & Reset	CMOS	MC54HC175	MC74HC175	16	N,J	D
	CMOS	MC54HC175A	MC74HC175A	16	N,J	D,SD
Quad D-Type Register With 3-State Outputs	CMOS	MC14076B	–	16	P,L	D
Quad Parallel Register With Enable	TTL	MC74F379	–	16	N	D
Quad With 3-State Outputs D Flip-Flop With Common Clock & Reset	CMOS	MC74HC173	–	16	N	D
Triple D Flip-Flop With Set and Reset	ECL	MC100LVEL30	MC100EL30	20		DW
<b>GATES, AND/NAND</b>						
13-Input NAND Gate	CMOS	MC74HC133	–	16	N	D
	TTL	SN54LS133	SN74LS133	16	N,J	D
8-Input NAND Gate	CMOS	MC74HC30	–	14	N	D
	TTL	SN54LS30	SN74LS30	14	N,J	D
	CMOS	MC14068B	–	14	P	D
Dual 4-Input AND Gate	TTL	MC74F21	–	14	N	D
	TTL	SN54LS21	SN74LS21	14	N,J	D
	CMOS	MC14082B	–	14	P,L	D
Dual 4-Input NAND Buffer	TTL	MC74F40	–	14	N	D
	TTL	SN54LS40	SN74LS40	14	N,J	D
Dual 4-Input NAND Gate	CMOS	MC74AC20	–	14	N	D
	CMOS	MC74ACT20	–	14	N	D
	TTL	MC74F20	–	14	N	D
	CMOS	MC74HC20	–	14	N	D
	TTL	SN54LS20	SN74LS20	14	N,J	D
	TTL	SN54LS22	SN74LS22	14	N,J	D
	CMOS	MC14012B	–	14	P,L	D
Dual 4-Input NAND Gate (Unbuffered)	CMOS	MC14012UB	–	14	P,L	D
Expandable NAND Gate	DTL	MC830	–	14	P,L	
Hex AND Gate	ECL	MC10197	–	16	P,L	FN
Low-Voltage CMOS Quad 2-Input AND Gate, 5V-Tolerant Inputs	CMOS	MC74LCX08	–	14		D,DT
Low-Voltage CMOS Quad 2-Input NAND Gate, 5V-Tolerant Inputs	CMOS	MC74LCX00	–	14		D,DT
Low-Voltage Quiet CMOS Quad 2-Input NAND Gate	CMOS	MC74LVQ00	–	14		D,M,DT,SD
Quad 2-Input AND Gate	CMOS	MC74AC08	–	14	N	D
	CMOS	MC74ACT08	–	14	N	D
	TTL	MC74F08	–	14	N	D
	CMOS	MC54HC08A	MC74HC08A	14	N,J	D,DT
	TTL	SN54LS08	SN74LS08	14	N,J	D
	TTL	SN54LS09	SN74LS09	14	N,J	D
	ECL	MC10H104	–	16	P,L	FN
	ECL	MC10104	–	16	P,L	FN
	CMOS	MC14081B	–	14	P,L	D
Quad 2-Input AND Gate With LSTTL-Compatible Inputs	CMOS	MC54HCT08A	MC74HCT08A	14	N,J	D
Quad 2-Input NAND Buffer	TTL	MC74F37	–	14	N	D
	TTL	SN54LS26	SN74LS26	14	N,J	D
	TTL	SN54LS37	SN74LS37	14	N,J	D

## Selection by Function

Description	Tech.	Device(s)		Pins	DIP	SM
<b>GATES, AND/NAND</b>						
Quad 2-Input NAND Buffer Open-Collector	TTL	MC74F38	-	14	N	D
Quad 2-Input NAND Buffer Open-Collector	TTL	SN54LS38	SN74LS38	14	N,J	D
Quad 2-Input NAND Gate	DTL	MC846	-	14	P,L	
	DTL	MC849	-	14	P,L	
	DTL	MC946	-	14	P,L	
	CMOS	MC74AC00	-	14	N	D
	CMOS	MC74ACT00	-	14	N	D
	TTL	MC74F00	-	14	N	D
	CMOS	MC54HC00A	MC74HC00A	14	N,J	D,DT
	TTL	SN54LS00	SN74LS00	14	N,J	D
	TTL	SN54LS01	SN74LS01	14	N,J	D
	TTL	SN54LS03	SN74LS03	14	N,J	D
CMOS	MC14011B	-	14	P,L	D	
Quad 2-Input NAND Gate (Unbuffered)	CMOS	MC14011UB	-	14	P,L	D
Quad 2-Input NAND Gate With LSTTL-Compatible Inputs	CMOS	MC54HCT00A	MC74HCT00A	14	N,J	D
Quad 2-Input NAND Gate With Open-Drain Outputs	CMOS	MC74HC03A	-	14	N	D,DT
Triple 3-Input AND Gate	CMOS	MC74AC11	-	14	N	D
	CMOS	MC74ACT11	-	14	N	D
	TTL	MC74F11	-	14	N	D
	CMOS	MC74HC11	-	14	N	D
	TTL	SN54LS11	SN74LS11	14	N,J	D
	TTL	SN54LS15	SN74LS15	14	N,J	D
	CMOS	MC14073B	-	14	P,L	D
Triple 3-Input NAND Gate	CMOS	MC74AC10	-	14	N	D
	CMOS	MC74ACT10	-	14	N	D
	TTL	MC74F10	-	14	N	D
	CMOS	MC74HC10	-	14	N	D
	TTL	SN54LS10	SN74LS10	14	N,J	D
	TTL	SN54LS12	SN74LS12	14	N,J	D
CMOS	MC14023B	-	14	P,L	D	
Triple 3-Input NAND Gate (Unbuffered)	CMOS	MC14023UB	-	14	P,L	D
<b>GATES, COMPLEX</b>						
2-Input AND/NAND Gate	ECL	MC10EL04	MC100EL04	8		D
2-Input Differential AND/NAND Gate	ECL	MC10EL05	MC100EL05	8		D
2-Input XOR/NOR Gate	ECL	MC10EL07	MC100EL07	8		D
2-Wide, 2-Input/2-Wide, 3-Input AND-NOR Gate	CMOS	MC74HC51	-	14	N	D
2-Wide, 2-Input/2-Wide, 3-Input AND-OR Gate	CMOS	MC74HC58	-	14	N	D
2-Wide, 4-Input AND/OR Invert Gate	TTL	SN54LS55	SN74LS55	14	N,J	D
3-2-2-3-Input AND/OR Invert Gate	TTL	SN54LS54	SN74LS54	14	N,J	D
4-2-3-2 Input AND-OR-Invert Gate	TTL	MC74F64	-	14	N	D
4-Bit AND/OR Selector	CMOS	MC14519B	-	16	P	D
	ECL	MC100EL01	MC100EL01	8		D
4-Input OR/NOR Gate	ECL	MC100LVEL01	-	8		D
	ECL	MC10H119	-	16	P,L	FN
4-Wide 4-3-3-3 Input OR-AND Gate	ECL	MC10119	-	16	P,L	FN
4-Wide OR-AND/OR-AND-Invert Gate	ECL	MC10H121	-	16	P,L	FN
4-Wide OR-AND/OR-AND-Invert Gate	ECL	MC10121	-	16	P,L	FN

## Selection by Function

Description	Tech.	Device(s)	Pins	DIP	SM
<b>GATES, COMPLEX</b>					
8-Input NOR/OR Gate	CMOS	MC74HC4078	–	14	N D
Dual 2 Wide 2-Input/3-Input AND/OR Invert Gate	TTL	SN54LS51	SN74LS51	14	N,J D
Dual 2-Wide 2-3-Input OR-AND/OR-AND-Invert Gate	ECL	MC10117	–	16	P,L FN
	ECL	MC10H117	–	16	P,L FN
Dual 2-Wide 2-Input, 2-Wide 3-Input AND-OR-Invert Gate	TTL	MC74F51	–	14	N D
Dual 2-Wide 3-Input OR-AND Gate	ECL	MC10H118	–	16	P,L FN
	ECL	MC10118	–	16	P,L FN
Dual 4-5 Input OR/NOR Gate	ECL	MC10H109	–	16	P,L FN
	ECL	MC10109	–	16	P,L FN
	ECL	MC10H209	–	16	P,L FN
Dual 4-Input NAND, 2-Input NOR/OR, 8-Input AND/NAND Gate (Unbuffered)	CMOS	MC14501UB	–	16	P D
Dual 4-Input OR/NOR Gate	ECL	MC1660	–	16	L
Dual 5-Input Majority Logic Gate	CMOS	MC14530B	–	16	P D
Dual Expandable AND OR Invert Gate (Unbuffered)	CMOS	MC14506UB	–	16	L
Hex NAND/NOR/Invert Gate (Unbuffered)	CMOS	MC14572UB	–	16	P D
High Speed Dual 3-Input 3-Output OR/NOR Gate	ECL	MC10212	–	16	P
Quad 4-Input OR/NOR Gate	ECL	MC10E101	MC100E101	28	FN
Quad Differential AND/NAND Gate	ECL	MC10E404	MC100E404	28	FN
Quad OR/NOR Gate	ECL	MC10H101	–	16	P,L FN
	ECL	MC10101	–	16	P,L FN
Quint 2-Input AND/NAND Gate	ECL	MC10E104	MC100E104	28	FN
Quint 2-Input XOR/XNOR Gate	ECL	MC10E107	MC100E107	28	FN
Triple 2-3-2 Input OR/NOR Gate	ECL	MC10H105	–	16	P,L FN
	ECL	MC10105	–	16	P,L FN
Triple 2-Input Exclusive OR/Exclusive NOR Gate	ECL	MC10H107	–	16	P,L FN
	ECL	MC10107	–	16	P,L FN
<b>GATES, EXCLUSIVE OR/EXCLUSIVE NOR</b>					
Low-Voltage CMOS Quad 2-Input Exclusive OR Gate With 5V Tolerant Inputs	CMOS	MC74LX86	–	14	D,M SD,DT
Quad 2-Input Exclusive NOR Gate	CMOS	MC74AC810	–	14	N DW
	CMOS	MC74ACT810	–	14	N DW
	CMOS	MC74HC7266	–	14	N D
	CMOS	MC74HC7266A	–	14	N D,DT
	TTL	SN54LS266	SN74LS266	14	N,J D
Quad Exclusive NOR Gate	CMOS	MC14077B	–	14	P,L D
Quad 2-Input Exclusive OR Gate	CMOS	MC74AC86	–	14	N D
	CMOS	MC74ACT86	–	14	N D
	TTL	MC74F86	–	14	N D
	CMOS	MC54HC86	MC74HC86	14	N,J D
	CMOS	MC54HC86A	MC74HC86A	14	N,J D,DT
	TTL	SN74LS136	–	14	N,J D
	TTL	SN54LS386	SN74LS386	14	N,J D
Quad Exclusive OR Gate	TTL	SN54LS86	SN74LS86	14	N,J D
	ECL	MC10H113	–	16	P,L FN
	ECL	MC10113	–	16	P,L FN
	CMOS	MC14070B	–	14	P,L D
Triple 2-Input Exclusive-OR Gate	ECL	MC1672	–	16	L

## Selection by Function

Description	Tech.	Device(s)	Pins	DIP	SM
<b>GATES, NOR</b>					
8-Input NOR Gate	CMOS	MC14078B	–	14	P D
Dual 3-Input 3-Output NOR Gate	ECL	MC10111	–	16	P,L FN
Dual 3-Input NOR Gate + Inverter (Unbuffered)	CMOS	MC14000UB	–	14	P,L D
Dual 3-Input, 3-Output NOR Gate	ECL	MC10H211	–	16	P,L FN
Dual 3-Input, 3-Output NOR Gate	ECL	MC10211	–	16	P,L FN
Dual 4-Input NOR Gate	CMOS	MC74HC4002	–	14	N D
	CMOS	MC14002B	–	14	P,L D
Dual 4-Input NOR Gate (Unbuffered)	CMOS	MC14002UB	–	14	P,L D
Dual 5-Input NOR Gate	TTL	SN54LS260	SN74LS260	14	N,J D
Low-Voltage CMOS Quad 2-Input NOR Gate, 5V-Tolerant Inputs	CMOS	MC74LCX02	–	14	D,DT
Quad 2-Input NOR Buffer	TTL	SN54LS28	SN74LS28	14	N,J D
	TTL	SN54LS33	SN74LS33	14	N,J D
Quad 2-Input NOR Gate	CMOS	MC74AC02	–	14	N D
	CMOS	MC74ACT02	–	14	N D
	TTL	MC74F02	–	14	N D
	CMOS	MC54HC02A	MC74HC02A	14	N,J D,DT
	TTL	SN54LS02	SN74LS02	14	N,J D
	ECL	MC10H102	–	16	P,L FN
	ECL	MC10102	–	16	P,L FN
	ECL	MC1662	–	16	L
CMOS	MC14001B	–	14	P,L D	
Quad 2-Input NOR Gate (Unbuffered)	CMOS	MC14001UB	–	14	P,L D
Quad 2-Input NOR Gate With strobe	ECL	MC10H100	–	16	P,L FN
	ECL	MC10100	–	16	P,L FN
Triple 3-Input NOR Gate	CMOS	MC54HC27	MC74HC27	14	N,J D
	TTL	SN54LS27	SN74LS27	14	N,J D
	CMOS	MC14025B	–	14	P,L D
Triple 3-Input NOR Gate (Unbuffered)	CMOS	MC14025UB	–	14	P,L D
Triple 4-3-3 Input NOR Gate	ECL	MC10H106	–	16	P,L FN
	ECL	MC10106	–	16	P,L FN
<b>GATES, OR</b>					
Dual 3-Input 3-Output OR Gate	ECL	MC10110	–	16	P,L FN
	ECL	MC10H210	–	16	P,L FN
	ECL	MC10210	–	16	P,L FN
Dual 4-Input OR Gate	CMOS	MC14072B	–	14	P D
Low-Voltage CMOS Quad 2-Input OR Gate, 5V-Tolerant Inputs	CMOS	MC74LCX32	–	14	D,DT
Low-Voltage Quiet CMOS Quad 2-Input OR Gate, 5V-Tolerant Inputs	CMOS	MC74LVQ32	–	14	D,M SD,DT
Quad 2-Input OR Gate	CMOS	MC74AC32	–	14	N D
	CMOS	MC74ACT32	–	14	N D
	TTL	MC74F32	–	14	N D
	CMOS	MC54HC32A	MC74HC32A	14	N,J D,DT
	CMOS	MC54HCT32A	MC74HCT32A	14	N,J D
	TTL	SN54LS32	SN74LS32	14	N,J D
	ECL	MC10H103	–	16	P,L FN
	ECL	MC10103	–	16	P,L FN
CMOS	MC14071B	–	14	P,L D	



## Selection by Function

Description	Tech.	Device(s)		Pins	DIP	SM
<b>GATES, OR</b>						
Triple 3-Input OR Gate	CMOS	MC74HC4075	–	14	N	D
	CMOS	MC14075B	–	14	P,L	D
<b>INDUSTRIAL CONTROL UNIT</b>						
Industrial Control Unit	CMOS	MC14500B	–	16	P	DW
<b>INVERTERS</b>						
Hex Inverter	DTL	MC836	–	14	P,L	
	DTL	MC837	–	14	P,L	
	DTL	MC936	–	14	P,L	
	DTL	MC937	–	14	P,L	
Hex Inverter (Without Input Diodes)	DTL	MC840	–	14	P,L	
<b>INVERTER/BUFFERS, 2-STATE</b>						
9-Bit Buffer	ECL	MC10E122	MC100E122	28		FN
Driver	ECL	MC10EL12	MC100EL12	8		D
Dual Complementary Pair Plus Inverter (Unbuffered)	CMOS	MC14007UB	–	14	P	D
Hex Buffer With Enable	ECL	MC10H188	–	16	P,L	FN
	ECL	MC10188	–	16	P,L	FN
Hex Buffer/Non-Inverting	CMOS	MC14050B	–	16	P,L	D
Hex Inverter	CMOS	MC74AC04	–	14	N	D
	CMOS	MC74ACT04	–	14	N	D
	TTL	MC74F04	–	14	N	D
	CMOS	MC54HC04A	MC74HC04A	14	N,J	D,SD,DT
	TTL	SN54LS04	SN74LS04	14	N,J	D
	TTL	SN54LS05	SN74LS05	14	N,J	D
Hex Inverter Gate (Unbuffered)	CMOS	MC14069UB	–	14	P,L	D
Hex Inverter With Enable	ECL	MC10H189	–	16	P,L	FN
	ECL	MC10189	–	16	P,L	FN
Hex Inverter With LSTTL Compatible Inputs	CMOS	MC74HCT04A	–	14	N	D,DT
Hex Inverter With open Drain Outputs	CMOS	MC74AC05	–	14	N	D
	CMOS	MC74ACT05	–	14	N	D
Hex Inverter With Strobe (Active Pullup)	HTL	MC677	–	14	P,L	
Hex Inverter With Strobe (Without Output Resistors)	HTL	MC678	–	14	P,L	
Hex Inverter/Buffer	ECL	MC10195	–	16	P,L	FN
	CMOS	MC14049B	–	16	P	D
Hex Inverter/Buffer (Unbuffered)	CMOS	MC14049UB	–	16	P,L	D
Hex Inverting Buffer/Logic-Level Down Converter	CMOS	MC54HC4049	MC74HC4049	16	N,J	D
Hex Non-Inverting Buffer/Logic-Level Down Converter	CMOS	MC54HC4050	MC74HC4050	16	N,J	D
Hex Unbuffered Inverter	CMOS	MC74HCU04	–	14	N	D
Low-Voltage CMOS Hex Inverter, With 5V-Tolerant Inputs	CMOS	MC74LCX04	–	14		D,DT
Low-Voltage Quiet CMOS Hex Inverter	CMOS	MC74LVQ04	–	14		D,M,SD,DT
Quad 2-Input Gate (Active Pullup)	HTL	MC672	–	14	P,L	
Quad 2-Input Gate (Passive Pullup)	HTL	MC668	–	14	P,L	
Quad Driver	ECL	MC10E112	MC100E112	28		FN
Strobed Hex Inverter/Buffer	CMOS	MC14502B	–	16	P,L	DW
Triple 3-Input Gate (Active Pullup)	HTL	MC671	–	14	P,L	
Triple 3-Input Gate (Passive Pullup)	HTL	MC670	–	14	P,L	

## Selection by Function

Description	Tech.	Device(s)		Pins	DIP	SM
<b>LATCHES</b>						
3–Bit 4:1 Mux–Latch (Integrated E156 & E171)	ECL	MC10E256	MC100E256	28		FN
3–Bit 4:1 Mux–Latch, With Common Enable, Asynchronous Master Reset, Differential Output	ECL	MC10E156	MC100E156	28		FN
4–Bit D Latch	TTL	SN54LS75	SN74LS75	16	N,J	D
	TTL	SN54LS77	SN74LS77	14	N,J	D
	TTL	SN54LS375	SN74LS375	16	N,J	D
5–Bit 2:1 Mux–Latch, With Common Enable, Asynchronous Master Reset Differential Output	ECL	MC10E154	MC100E154	28		FN
6–Bit 2:1 Mux–Latch, With Common Enable, Asynchronous Master Reset Single Ended	ECL	MC10E155	MC100E155	28		FN
6–Bit D Latch	ECL	MC10E150	MC100E150	28		FN
8–Bit Addressable Latch	CMOS	MC74AC259	–	16	N	D
	CMOS	MC74ACT259	–	16	N	D
	TTL	MC74F259	–	16	N	D
	TTL	SN54LS259	SN74LS259	16	N,J	D
	CMOS	MC14099B	–	16	P	DW
	CMOS	MC14599B	–	18	P	
8–Bit Bus Compatible Addressable Latch	CMOS	MC14598B	–	18	P,L	
9–Bit Latch, With Parity	ECL	MC10E175	MC100E175	28		FN
Dual Latch	ECL	MC10H130	–	16	P,L	FN
Dual 2–Bit Transparent Latch	CMOS	MC74HC75	–	16	N	D
Dual 4–Bit Addressable Latch	CMOS	MC74AC256	–	16	N	DW
	CMOS	MC74ACT256	–	16	N	DW
	TTL	MC74F256	–	16	N	D
	TTL	SN54LS256	–	16	N,J	D
Dual 4–Bit Latch	CMOS	MC14508B	–	24	P,L	DW
Dual Latch	ECL	MC10130	–	16	P,L	FN
Low–Voltage CMOS Octal Transparent Latch, 3–State, Non–Inverting With 5V Tolerant Inputs and Outputs	CMOS	MC74LCX373	–	20		DW,M,DT
Low–Voltage CMOS 16–Bit Transparent Latch, 3–State, Non–Inverting With 5V Tolerant Inputs and Outputs	CMOS	MC74LCX16373	–	48		DT
Low–Voltage CMOS Octal Transparent Latch Flow Through Pinout, 3–State, Non–Inverting With 5V Tolerant Inputs and Outputs	CMOS	MC74LCX573	–	20		DW,M,SD,DT
Low–Voltage Quiet CMOS Octal Transparent Latch	CMOS	MC74LVQ373	–	20		DW,M,SD,DT
Low–Voltage Quiet CMOS Octal Transparent Latch Flow Through Pinout	CMOS	MC74LVQ573	–	20		DW,M,SD,DT
Octal 3–State Non–Inverting Transparent Latch With LSTTL Compatible Inputs	CMOS	MC54HCT373A	MC74HCT373A	20	N,J	DW,SD,DT
Octal D Latch With 3–State Outputs	CMOS	MC74AC563	–	20	N	DW
	CMOS	MC74ACT563	–	20	N	DW
	CMOS	MC74AC573	–	20	N	DW
	CMOS	MC74ACT573	–	20	N	DW
Octal Transparent Latch With 3–State Outputs	CMOS	MC74AC373	–	20	N	DW
	CMOS	MC74ACT373	–	20	N	DW
	TTL	SN54LS373	SN74LS373	20	N,J	DW
	TTL	MC74F373	–	20	N	DW
	TTL	MC74F533	–	20	N	DW
	CMOS	MC74AC533	–	20	N	DW
CMOS	MC74ACT533	–	20	N	DW	

## Selection by Function

Description	Tech.	Device(s)		Pins	DIP	SM
<b>LATCHES</b>						
Octal With 3-State Outputs Inverting Transparent Latch	CMOS	MC54HC533A	MC74HC533A	20	N,J	DW
	CMOS	MC54HC563A	MC74HC563A	20	N,J	DW,DT
Octal With 3-State Outputs Non-Inverting Transparent Latch	CMOS	MC54HC373A	MC74HC373A	20	N,J	DW,DT
	CMOS	MC54HC573A	MC74HC573A	20	N,J	DW
Octal With 3-State Outputs Non-Inverting Transparent Latch With LSTTL Compatible Inputs	CMOS	MC74HCT573A	–	20	N	DW
Quad Latch	ECL	MC10133	–	16	P,L	FN
	ECL	MC10153	–	16	P,L	FN
	ECL	MC10168	–	16	P	
Quad NAND R-S Latch	CMOS	MC14044B	–	16	P	D
Quad NOR R-S Latch	CMOS	MC14043B	–	16	P,L	D
Quad Set/Reset Latch	TTL	SN54LS279	SN74LS279	16	N,J	D
Quad Transparent Latch	CMOS	MC14042B	–	16	P,L	D
Quint Latch	ECL	MC10H175	–	16	P,L	FN
	ECL	MC10175	–	16	P,L	FN
<b>MEMORY SUPPORT</b>						
4-Bit ECL-TTL Load Reducing DRAM Driver	ECL	MC10H660	MC100H660	28		FN
<b>MISCELLANEOUS</b>						
Data Separator	ECL	MC10E197	–	28		FN
<b>MULTIPLEXER/DATA SELECTORS</b>						
1-of-8 Decoder/Demultiplexer	CMOS	MC74AC151	–	16	N	D
	CMOS	MC74ACT151	–	16	N	D
16-Channel Analog Multiplexer/Demultiplexer	CMOS	MC14067B	–	24	P	DW
16:1 Multiplexer	ECL	MC10E164	MC100E164	28		FN
2-Bit 8:1 Multiplexer	ECL	MC10E163	MC100E163	28		FN
2:1 Multiplexer	ECL	MC10EL58	MC100EL58	8		D
3-Bit 4:1 Multiplexer, With Split Select Differential Output	ECL	MC10E171	MC100E171	28		FN
4:1 Differential Multiplexer	ECL	MC10EL57	MC100EL57	16		D
5-Bit 2:1 Multiplexer, With Differential Output	ECL	MC10E158	MC100E158	28		FN
8-Channel Analog Multiplexer/Demultiplexer With Address Latch	CMOS	MC54HC4351	MC74HC4351	20	N,J	DW
8-Channel Analog Multiplexer/Demultiplexer	CMOS	MC54HC4051	MC74HC4051	16	N,J	D, DW, DT
	CMOS	MC14051B	–	16	P,L	D
8-Channel Data Selector	CMOS	MC14512B	–	16	P,L	D
8-Input Data Selector/Multiplexer	CMOS	MC74HC151	–	16	N	D
8-Input Data Selector/Multiplexer With 3-State Outputs	CMOS	MC54HC251	MC74HC251	16	N,J	D
8-Input Multiplexer	TTL	MC74F151	–	16	N	D
	TTL	SN54LS151	SN74LS151	16	N,J	D
8-Input Multiplexer With 3-State Outputs	TTL	SN54LS251	SN74LS251	16	N,J	D
	TTL	MC74F251	–	16	N	D
	CMOS	MC74AC251	–	16	N	D
	CMOS	MC74ACT251	–	16	N	D
8-Input Data Selector/Multiplexer With Data and Address Latches and With 3-State Outputs	CMOS	MC54HC354	MC74HC354	20	N,J	DW
8-Line Multiplexer	ECL	MC10H164	–	16	P,L	FN
	ECL	MC10164	–	16	P,L	FN
Analog Multiplexer/Demultiplexer With Injection Current Effect Control, Automotive Customized	CMOS	MC74HC4851A	MC74HC4852A	16	N	D,DW, DT
		MC74HC4853A	–			

## Selection by Function

Description	Tech.	Device(s)		Pins	DIP	SM
<b>MULTIPLEXER/DATA SELECTORS</b>						
Dual 4-Channel Analog Data Selector	CMOS	MC14529B	–	16	P	D
Dual 4-Channel Analog Multiplexer/Demultiplexer	CMOS	MC74HC4052	–	16	N	D, DW
	CMOS	MC14052B	–	16	P,L	D
Dual 4-Channel Data Selector/Multiplexer	CMOS	MC14539B	–	16	P	D
Dual 4-Input Data Selector/Multiplexer	CMOS	MC74HC153	–	16	N	D
Dual 4-Input Data Selector/Multiplexer With 3-State Outputs	CMOS	MC74HC253	–	16	N	D
Dual 4-Input Multiplexer	CMOS	MC74AC153	–	16	N	D
	CMOS	MC74ACT153	–	16	N	D
	CMOS	MC74AC352	–	16	N	DW
	CMOS	MC74ACT352	–	16	N	DW
	TTL	MC74F153	–	16	N	D
	TTL	MC74F352	–	16	N	D
	TTL	SN54LS153	SN74LS153	16	N,J	D
Dual 4-Input Multiplexer With 3-State Outputs	TTL	SN54LS352	SN74LS352	16	N,J	D
	CMOS	MC74AC253	–	16	N	DW
	CMOS	MC74ACT253	–	16	N	DW
	CMOS	MC74AC353	–	16	N	D
	CMOS	MC74ACT353	–	16	N	D
	TTL	SN54LS253	SN74LS253	16	N,J	D
	TTL	SN54LS353	SN74LS353	16	N,J	D
Dual 4-to-1 Multiplexer	TTL	MC74F253	–	16	N	D
	TTL	MC74F353	–	16	N	D
	ECL	MC10H174	–	16	P,L	FN
Dual Differential 2:1 Multiplexer (3.3V)	ECL	MC10174	–	16	P,L	FN
	ECL	MC100LVEL56	MC100EL56	20		DW
Dual Multiplexer With Latch	ECL	MC10134	–	16	P,L	FN
Dual Multiplexer With Latch and Common Reset	ECL	MC10132	–	16	P,L	FN
Low Voltage 16:1 Multiplexer	ECL	MC100LVE164	–	32		FA
Quad 2-Input Multiplexer With Latch	ECL	MC10H173	–	16	P,L	FN
Quad 2-Channel Analog Multiplexer/Demultiplexer	CMOS	MC14551B	–	16	P	D
Quad 2-Input Data Selector/Multiplexer	CMOS	MC54HC158	MC74HC158	16	N,J	D
	CMOS	MC74HC158A	–	16	N,J	D,DT
Quad 2-Input Data Selector/Multiplexer With 3-State Outputs	CMOS	MC74HC257	–	16	N	D
Quad 2-Input Data Selector/Multiplexer With LSTTL Compatible Inputs	CMOS	MC74HCT157A	–	16	N	D
Quad 2-Input Data Selectors/Multiplexers	CMOS	MC54HC157A	MC74HC157A	16	N,J	D,DT
Quad 2-Input Multiplexer	TTL	MC74F157A	–	16	N	D
	TTL	MC74F158A	–	16	N	D
	TTL	SN54LS157	SN74LS157	16	N,J	D
	TTL	SN54LS158	SN74LS158	16	N,J	D
Quad 2-Input Multiplexer (Inverting)	ECL	MC10159	–	16	P,L	FN
Quad 2-Input Multiplexer (Non-Inverting)	ECL	MC10158	–	16	P,L	FN
Quad 2-Input Multiplexer Inverting With 3-State Outputs	CMOS	MC74AC258	–	16	N	DW
	CMOS	MC74ACT258	–	16	N	DW
Quad 2-Input Multiplexer Non-Inverting With 3-State Outputs	CMOS	MC74ACT257	–	16	N	D
	CMOS	MC74AC257	–	16	N	D
Quad 2-Input Multiplexer With 3-State Outputs	TTL	SN54LS257B	SN74LS257B	16	N,J	D
Quad 2-Input Multiplexer With Storage	TTL	SN54LS298	SN74LS298	16	N,J	D

## Selection by Function

Description	Tech.	Device(s)	Pins	DIP	SM
<b>MULTIPLEXER/DATA SELECTORS</b>					
Quad 2-Input Multiplexer, Inverting	CMOS	MC74AC158	-	16	N, D
	CMOS	MC74ACT158	-	16	N, D
Quad 2-Input Multiplexer, Inverting Output	ECL	MC10H159	-	16	P,L, FN
Quad 2-Input Multiplexer, Inverting, With 3-State Outputs	TTL	SN54LS258B	SN74LS258B	16	N,J, D
Quad 2-Input Multiplexer, Non-Inverting	CMOS	MC74AC157	-	16	N, D
	CMOS	MC74ACT157	-	16	N, D
Quad 2-Input Multiplexer, Non-Inverting Output	ECL	MC10H158	-	16	P,L, FN
Quad 2-Input Multiplexer, With 3-State Outputs	TTL	MC74F257A	-	16	N, D
	TTL	MC74F258A	-	16	N, D
Quad 2-Input Multiplexer/Latch	ECL	MC10173	-	16	P,L, FN
Quad 2-Port Register	TTL	MC74F398	-	20	N, DW
	TTL	MC74F399	-	16	N, D
	TTL	SN54LS398	SN74LS398	20	N,J, DW
	TTL	SN54LS399	SN74LS399	16	N,J, D
Quad 2:1 Mux, Individual-Select	ECL	MC10E157	MC100E157	28	FN
Quad Analog Switch/Multiplexer	CMOS	MC14016B	-	14	P,L, D
	CMOS	MC14066B	-	14	P,L, D
Quad Analog Switch/Multiplexer/Demultiplexer	CMOS	MC54HC4016	MC74HC4016	14	N,J, D
	CMOS	MC54HC4066	MC74HC4066	14	N,J, D,DT
Quad Analog Switch/Multiplexer/Demultiplexer With Separate Analog/Digital Power Supplies	CMOS	MC74HC4316	-	16	N, D
Triple 2-Channel Analog Multiplexer/Demultiplexer	CMOS	MC54HC4053	MC74HC4053	16	N,J, D, DW
	CMOS	MC14053B	-	16	P,L, D
Triple 2-Channel Analog Multiplexer/Demultiplexer With Address Latch	CMOS	MC54HC4353	MC74HC4353	20	N,J, DW
Triple 2:1 Multiplexer	ECL	MC100EL59	-	20	DW
Triple 2:1 Multiplexer (3.3V)	ECL	MC100LVEL59	-	20	DW
Triple Differential 2:1 Multiplexer	ECL	MC100E457	-	28	FN
	ECL	MC10E457	-	28	FN
<b>MULTIVIBRATORS</b>					
130MHz Voltage Controlled Multivibrator	ECL	MC12101	-	20	P, FN
200 MHz Voltage Controlled Multivibrator	ECL	MC12100	-	20	P, FN
Dual Monostable Multivibrator	HTL	MC667	-	14	P,L
	CMOS	MC14528B	-	16	P,L, D
Dual Monstable Multivibrators With Schmitt Trigger Inputs	TTL	SN54LS221	SN74LS221	16	N,J, D
Dual Precision Monostable Multivibrator (Retriggerable, Resettable)	CMOS	MC54HC4538A	MC74HC4538A	16	N,J, D
Dual Precision Monostable Multivibrator	CMOS	MC14538B	-	16	P,L, D, DW
Dual Voltage-Controlled Multivibrator	ECL	MC4024	-	14	P,L
Monostable Multivibrator	DTL	MC951	-	14	P,L
	ECL	MC10198	-	16	P,L, FN
Retriggerable Monostable Multivibrators	TTL	SN54LS122	SN74LS122	14	N,J, D
	TTL	SN54LS123	SN74LS123	14	N,J, D
Voltage Controlled Multivibrator	ECL	MC1658	-	16	P,L, D, FN
<b>OSCILLATORS</b>					
7-Stage Binary Ripple Counter	CMOS	MC74HC4024	-	14	N, D
Crystal Oscillator	ECL	MC12061	-	16	P,L
Dual Voltage-Controlled Multivibrator	ECL	MC4324	-	14	P,L
Low Power Voltage Controlled Oscillator	ECL	MC12148	-	8	D,SD

## Selection by Function

Description	Tech.	Device(s)	Pins	DIP	SM
<b>OSCILLATORS</b>					
Voltage Controlled Oscillator	ECL	MC1648	–	14	P,L D, FN
<b>OSCILLATOR/TIMERS</b>					
24–Stage Frequency Divider	CMOS	MC14521B	–	16	P,L D
Programmable Oscillator Timer	CMOS	MC14541B	–	14	P,L D
Programmable Timer	CMOS	MC14536B	–	16	P,L DW
Quad Precision Timer/Driver	CMOS	MC14415	–	16	P,L DW
<b>PARITY CHECKERS</b>					
12–Bit Parity Generator/Checker	ECL	MC10H160	–	16	P,L FN
	ECL	MC10I160	–	16	P,L FN
12–Bit Parity Generator/Checker, Register–Shiftable, Diff Output	ECL	MC10E160	MC100E160	28	FN
12–Bit Parity Tree	CMOS	MC14531B	–	16	P D
9 + 2–Bit Parity Generator–Checker	ECL	MC10170	–	16	P,L FN
9–Bit Odd/Even Parity Generator/Checker	CMOS	MC74HC280	–	14	N D
	TTL	SN54LS280	SN74LS280	14	N,J D
9–Bit Parity Generator/Checker	TTL	MC74F280	–	14	N D
Error Detection and Correction Circuit	ECL	MC10E193	MC100E193	28	FN
<b>PHASE–LOCKED LOOP</b>					
Phase–Locked Loop	CMOS	MC14046B	–	16	P,L DW
<b>PRESCALERS</b>					
1.1GHz +10/20/40/80 Prescaler	ECL	MC12080	–	8	P D
1.1GHz +126/128, +254/256 Low Power Dual Modulus Prescaler	ECL	MC12058	–	8	D,SD
1.1GHz +127/128, +255/256 Low Power Dual Modulus Prescaler	ECL	MC12038A	–	8	P D
1.1GHz +8/9, +16/17 Dual Modulus Prescaler	ECL	MC12026A	–	8	P D
	ECL	MC12026B	–	8	P D
1.1GHz +2 Low Power Prescaler With Stand–By Mode	ECL	MC12083	–	8	P D
1.1GHz +2/4/8 Low Power Prescaler With Stand–By Mode	ECL	MC12093	–	8	P D,SD
1.1GHz +256 Prescaler	ECL	MC12074	–	8	P D
1.1GHz +32/33, +64/65 Dual Modulus Prescaler	ECL	MC12028A	–	8	P D
1.1GHz +32/33, +64/65 Dual Modulus Prescaler	ECL	MC12028B	–	8	P D
1.1GHz +64 Prescaler	ECL	MC12073	–	8	P D
1.1GHz +64/65, +128/129 Dual Modulus Prescaler	ECL	MC12022A	–	8	P D
	ECL	MC12022B	–	8	P D
	ECL	MC12022SLA	–	8	P D
	ECL	MC12022SLB	–	8	P D
	ECL	MC12022TSA	–	8	P D
	ECL	MC12022TSB	–	8	P D
1.1GHz +64/65, +128/129 Dual Modulus Prescaler With Stand–By Mode	ECL	MC12036A	–	8	P D
	ECL	MC12036B	–	8	P D
1.1GHz +64/65, +128/129 Low Voltage Dual Modulus Prescaler	ECL	MC12022LVA	–	8	P D
	ECL	MC12022LVB	–	8	P D
	ECL	MC12022TVA	–	8	P D
	ECL	MC12022TVB	–	8	P D
1.1GHz +64/65, +128/129 Super Low Power Dual Modulus Prescaler	ECL	MC12052A	–	8	D,SD
1.1GHz +64/65, +128/129 Super Low Power Dual Modulus Prescaler With Stand–By Mode	ECL	MC12053A	–	8	D,SD
1.3GHz +64 Prescaler	ECL	MC12075	–	8	P D
1.3GHz +64/256 Prescaler	ECL	MC12066	–	8	D

## Selection by Function

Description	Tech.	Device(s)	Pins	DIP	SM
<b>PRESCALERS</b>					
1.3GHz +256 Prescaler	ECL	MC12076	–	8	P, D
	ECL	MC12078	–	8	P, D
2.0GHz +32/33, +64/65 Dual Modulus Prescaler	ECL	MC12034A	–	8	P, D
	ECL	MC12034B	–	8	P, D
2.0GHz +32/33, +64/65 Low Voltage Dual Modulus Prescaler	ECL	MC12033A	–	8	P, D
	ECL	MC12033B	–	8	P, D
2.0GHz +64/65, +128/129 Dual Modulus Prescaler	ECL	MC12032A	–	8	P, D
	ECL	MC12032B	–	8	P, D
2.0GHz +64/65, +128/129 Low Voltage Dual Modulus Prescaler	ECL	MC12031A	–	8	P, D
	ECL	MC12031B	–	8	P, D
2.0GHz +64/65, +128/129 Super Low Power Dual Modulus Prescaler	ECL	MC12054A	–	8	D,SD
2.5GHz +2, +4 Low Power Prescaler With Satnd-By Mode	ECL	MC12095	–	8	D,SD
2.5GHz +8192 Prescaler	ECL	MC12098	–	8	D
2.8GHz +64/128/256 Prescaler	ECL	MC12079	–	8	P, D
	ECL	MC12089	–	8	P, D
225MHz +20/21 Dual Modulus Prescaler	ECL	MC12019	–	8	P,L, D
225MHz +32/33 Dual Modulus Prescaler	ECL	MC12015	–	8	P,L, D
225MHz +40/41 Dual Modulus Prescaler	ECL	MC12016	–	8	P,L, D
225MHz +64 Prescaler	ECL	MC12023	–	8	P, D
225MHz +64/65 Dual Modulus Prescaler	ECL	MC12017	–	8	P,L, D
480MHz +5/6 Dual Modulus Prescaler	ECL	MC12009	–	16	P,L
520MHz +128/129 Dual Modulus Prescaler	ECL	MC12018	–	8	P,L, D
520MHz +64/65 Dual Modulus Prescaler	ECL	MC12025	–	8	P, D
550MHz +10/11 Dual Modulus Prescaler	ECL	MC12013	–	16	P,L
550MHz +8/9 Dual Modulus Prescaler	ECL	MC12011	–	16	P,L
750MHz +2 UHF Prescaler	ECL	MC12090	–	16	P,L
<b>PROGRAMMABLE DELAY CHIPS</b>					
Programmable Delay Chip (Dig 80ps Anal. 1.6 Ps/mv)	ECL	MC10E196	MC100E196	28	FN
Programmable Delay Chip (Digitally Selectable 20ps Res)	ECL	MC10E195	MC100E195	28	FN
<b>PROMs</b>					
1024-Bit Programmable Read Only Memory	ECL	MCM10149*25	–	16	L
32 X 8-Bit Programmable Read Only Memory	ECL	MCM10139	–	16	L
<b>RAMs</b>					
1024 X 1-Bit Random Access Memory	ECL	MCM10146	–	16	L
256 X 1-Bit Random Access Memory	ECL	MCM10152	–	16	L
<b>RECEIVERS</b>					
Differential Receiver	ECL	MC10EL16	MC100EL16	8	D
	ECL	MC100LVEL16	–	8	D
High Speed Triple Line Receiver	ECL	MC10216	–	16	P,L, FN
Low-Voltage Quad Differential Line Receiver	ECL	MC100LVEL17	MC100EL17	20	DW
Quad Bus Receiver	ECL	MC10129	–	16	L
Quad Line Receiver	ECL	MC10H115	–	16	P,L, FN
	ECL	MC10115	–	16	P,L, FN
	ECL	MC1692	–	16	L
Quint Differential Line Receiver	ECL	MC10E116	MC100E116	28	FN
	ECL	MC10E416	MC100E416	28	FN

## Selection by Function

Description	Tech.	Device(s)	Pins	DIP	SM
<b>RECEIVERS</b>					
Triple Line Receiver	ECL	MC10H116	–	16	P,L D, FN
	ECL	MC10114	–	16	P,L FN
	ECL	MC10116	–	16	P,L FN
<b>REGISTERS</b>					
4 X 4 Multiport Register	CMOS	MC14580B	–	24	P,L D
Hex Parallel D Register With Enable	TTL	MC74F378	–	16	N D
<b>REGISTER FILES</b>					
16 X 4–Bit Register File (RAM)	ECL	MC10H145	–	16	P,L FN
4 X 4 Register File Open Collector	TTL	SN54LS170	SN74LS170	16	N,J D
4 X 4 Register File With 3–State Outputs	TTL	SN54LS670	SN74LS670	16	N,J D
64–Bit Register File (RAM)	ECL	MCM10145	–	16	L
8 X 2 Multiport Register File (RAM)	ECL	MCM10143	–	24	L
<b>SCHMITT TRIGGERS</b>					
Dual 4–Input NAND Schmitt Trigger	TTL	MC74F13	–	14	N D
	TTL	SN54LS13	SN74LS13	14	N,J D
Dual Schmitt Trigger	CMOS	MC14583B	–	16	P D
Hex Inverter Schmitt Trigger	CMOS	MC74AC14	–	14	N D
	CMOS	MC74ACT14	–	14	N D
	TTL	MC74F14	–	14	N D
	TTL	SN54LS14	SN74LS14	14	N,J D
Hex Schmitt Trigger	CMOS	MC14106B	–	14	P,L D
	CMOS	MC14584B	–	14	P,L D
Hex Schmitt Trigger Inverter	CMOS	MC54HC14A	MC74HC14A	14	N,J D, DT
	CMOS	MC54HCT14A	MC74HCT14A	14	N,J D
Quad 2–Input NAND Gate With Schmitt Trigger Inputs	CMOS	MC54HC132A	MC74HC132A	14	N,J D
Quad 2–Input NAND Schmitt Trigger	CMOS	MC74AC132	–	14	N D
	CMOS	MC74ACT132	–	14	N D
	TTL	MC74F132	–	14	N D
	CMOS	MC14093B	–	14	P,L D
Quad 2–Input Schmitt Trigger NAND Gate	TTL	SN54LS132	SN74LS132	14	N,J D
<b>SCSI BUS TERMINATORS</b>					
9–Bit Switchable Active SCSI–2 Bus Term (110Ω) with Volt Reg	CMOS	MCCS142237	–	16,20	DW, DT
9–Bit Switchable SCSI Bus Term (110Ω: Active)	CMOS	MCCS142234	–	16	D
9–Bit Switchable SCSI Bus Term (220Ω & 330Ω: Passive)	CMOS	MCCS142233	–	20	FN
18–Bit Active SCSI Bus Terminator (* Also Available in 32–Pin QFP Package)	CMOS	MCCS142235	–	24,32	DW,*F A
18–Bit Switchable Active SCSI–2 Bus Term (110Ω) with Volt Reg	CMOS	MCCS142236	–	28	DW
18–Bit Switchable Active SCSI–2 Bus Term (110Ω) with Volt Reg Plus Inverted Disconnect	CMOS	MCCS142238	–	28	DW
<b>SERIAL EPROMs</b>					
Serial EPROM for MPA1016: 8–Pin DIP and SOIC; 20–Pin PLCC	CMOS	MPA1765	–	8,20	N D, FN
Serial EPROM for MPA1036: 8–Pin DIP and SOIC; 20–Pin PLCC	CMOS	MPA17128	–	8,20	P D, FN
<b>SHIFT REGISTERS</b>					
1–to–64–Bit Variable Length Shift Register	CMOS	MC14557B	–	16	P,L DW
128–Bit Static Shift Register	CMOS	MC14562B	–	14	P,L
18–Bit Static Shift Register	CMOS	MC14006B	–	14	P,L D
3–Bit Scannable Registered Address Driver, ECL	ECL	MC10E212	MC100E212	28	FN



## Selection by Function

Description	Tech.	Device(s)	Pins	DIP	SM
<b>SHIFT REGISTERS</b>					
4-Bit Bidirectional Universal Shift Register	CMOS	MC74AC194	–	16	N D
	CMOS	MC74ACT194	–	16	N D
		MC74F194	–	16	N D
	CMOS	MC74HC194	–	16	N
4-Bit Shift Register	TTL	SN54LS194A	SN74LS194A	16	N,J D
	TTL	MC74F195	–	16	N D
	TTL	SN54LS95B	SN74LS95B	14	N,J D
4-Bit Shift Register With 3-State Outputs	CMOS	MC14035B	–	16	P,L D
	TTL	SN74LS395	–	16	N,J D
4-Bit Shifter With 3-State	CMOS	MC74AC350	–	16	N D
	CMOS	MC74ACT350	–	16	N D
4-Bit Shifter, With 3-State Outputs	TTL	MC74F350	–	16	N D
4-Bit Universal Shift Register	CMOS	MC74HC195	–	16	N
	ECL	MC10H141	–	16	P,L FN
	ECL	MC10141	–	16	P,L FN
	CMOS	MC14194B	–	16	P,L D
8-Bit Bidirectional Universal Shift Register With parallel I/O	CMOS	MC74HC299	–	20	N DW
8-Bit Parallel-to-Serial Shift Register	TTL	SN54LS165	SN74LS165	16	N,J D
8-Bit Scannable Register	ECL	MC10E241	MC100E241	28	FN
8-Bit Serial In-Serial Out Shift Register	TTL	MC74F164	–	14	N D
8-Bit Serial or Parallel-Input/Serial-Output Shift Register	CMOS	MC54HC165	MC74HC165	16	N,J D
8-Bit Serial or Parallel-Input/Serial-Output Shift Register With 3-State Outputs	CMOS	MC54HC589	MC74HC589	16	N,J D
	CMOS	MC54HC589A	MC74HC589A	16	N,J D,SD DT
8-Bit Serial or Parallel-Input/Serial-Output Shift Register With Input Latch	CMOS	MC54HC597	MC74HC597	16	N,J D
	CMOS	MC54HC597A	MC74HC597A	16	N,J D,DT
8-Bit Serial-In/Parallel-Out Shift Register	TTL	SN54LS164	SN74LS164	14	N,J D
8-Bit Serial-Input/Parallel-Output Shift Register	CMOS	MC54HC164	MC74HC164	14	N,J D
	CMOS	MC54HC164A	MC74HC164A	14	N,J D,DT
8-Bit Serial-Input/Serial or Parallel-Output Shift Register With Latched 3-State Outputs	CMOS	MC54HC595A	MC74HC595A	16	N,J D,DT
8-Bit Shift Register	ECL	MC10E141	MC100E141	28	FN
	TTL	SN54LS166	SN74LS166	16	N,J D
8-Bit Shift Registers With Sign Extend	TTL	SN54LS322A	SN74LS322A	20	N,J DW
8-Bit Shift/Storage Register With 3-State Outputs	TTL	SN54LS299	SN74LS299	20	N,J DW
	TTL	SN54LS323	SN74LS323	20	N,J DW
8-Bit Static Shift Register	CMOS	MC14014B	–	16	P,L D
	CMOS	MC14021B	–	16	P,L D
8-Input Shift/Storage Register W/Synchronous Reset and Common I/O Pins	TTL	MC74F323	–	20	N DW
8-Input Universal Shift/Storage Register With Common Parallel I/O Pins: With 3-State Outputs	CMOS	MC74AC299	–	20	N DW
	CMOS	MC74ACT299	–	20	N DW
8-Input Universal Shift/Storage Register With Syn Reset/Common Parallel I/O Pins: With 3-State Outputs	CMOS	MC74AC323	–	20	N DW
	CMOS	MC74ACT323	–	20	N DW
8-Input Universal Shift/Storage Register, W/Common Parallel I/O Pins	TTL	MC74F299	–	20	N DW
8-Stage Shift/Store Register With 3-State Outputs	CMOS	MC14094B	–	16	P,L D
9-Bit Shift Register, 700MHz, With Asynchronous Master Reset	ECL	MC10E142	MC100E142	28	FN
Dual 5-Bit Shift Register	CMOS	MC14015B	–	16	P,L D

## Selection by Function

Description	Tech.	Device(s)		Pins	DIP	SM
<b>SHIFT REGISTERS</b>						
Dual 64–Bit Static Shift Register	CMOS	MC14517B	–	16	P	DW
Successive Approximation Register	CMOS	MC14549B	–	16	P,L	DW
	CMOS	MC14559B	–	16	P,L	DW
Universal 4–Bit Shift Register	TTL	SN54LS195A	SN74LS195A	16	N,J	D
<b>SYNTHESIZERS</b>						
1.1GHz Serial Input Synthesizer With +64/65, +128/129 Prescaler	ECL	MC12202	–	16,20		D,M,DT
125–1000MHz Frequency Synthesizer With Parallel Programming Interface	ECL	MC12181	–	16		DT
2.0GHz Serial Input Synthesizer With +64/65, +128/129 Prescaler	ECL	MC12206	–	16,20		D,DT
2.5GHz Serial Input Synthesizer With +32/33, +64/65 Prescaler	ECL	MC12210	–	16,20		D,DT
2.7GHz Frequency Synthesizer	ECL	MC12179	–	8		D
<b>TRANSCEIVERS</b>						
25Ω Octal Bidirectional Transceiver w/ 3–State Inputs and Outputs	ECL	MC74F2245	–	20		DW,SD
4–Bit Differential ECL Bus/TTL Bus Transceiver	ECL	MC10H680	MC100H680	28		FN
ECL/TTL Inverting Bidirectional Transceivers With Latch (4–Bit)	ECL	MC10804	–	16	L	
ECL/TTL Inverting Bidirectional Transceivers With Latch (5–Bit)	ECL	MC10805	–	20	L	
Hex ECL/TTL Transceiver With Latches	ECL	MC10H681	MC100H681	28		FN
Low–Voltage CMOS 16–Bit Latching Transceiver, 3–State, Non–Inverting With 5V Tolerant Inputs and Outputs	CMOS	MC74LCX16543A	–	56		DT
Low–Voltage CMOS 16–Bit Transceiver, 3–State, Non–Inverting With 5V Tolerant Inputs and Outputs	CMOS	MC74LCX16245	–	48		DT
Low–Voltage CMOS Octal Transceiver, 3–State, Non–Inverting With 5V Tolerant Inputs and Outputs	CMOS	MC74LCX245	–	20		M,DW,DT
Low–Voltage Quiet CMOS Octal Transceiver, 3–State, Non–Inverting	CMOS	MC74LVQ245	–	20		M,DW,SD,DT
Low–Voltage CMOS Octal Transceiver/Registered Transceiver With 5V Tolerant Inputs and Outputs	CMOS	MC74LCX646	–	24		DW,SD,DT
Low–Voltage Quiet CMOS Octal Transceiver/Registered Transceiver	CMOS	MC74LVQ646	–	24		DW,SD,DT
Low–Voltage Quiet CMOS Octal Transceiver/Registered Transceiver	CMOS	MC74LVQ652	–	24		DW,SD,DT
Octal Bus Transceiver/Inverting With Open Collector	TTL	SN54LS642	SN74LS642	20	N,J	DW
Octal Bus Transceiver/Non–Inverting With Open Collector	TTL	SN54LS641	SN74LS641	20	N,J	DW
Quad Futurebus Backplane Transceiver, With 3–State Outputs and Open Collector	TTL	MC74F3893A	–	20		FN
<b>TRANSLATORS</b>						
9–Bit ECL/TTL Translator	ECL	MC10H601	MC100H601	28		FN
9–Bit Latch ECL/TTL Translator	ECL	MC10H603	MC100H603	28		FN
9–Bit Latch TTL/ECL Translator	ECL	MC10H602	MC100H602	28		FN
9–Bit TTL/ECL Translator	ECL	MC10H600	MC100H600	28		FN
Differential ECL/TTL Translator	ECL	MC10ELT25	MC100ELT25	8		D
Differential PECL/TTL Translator	ECL	MC10ELT21	MC100ELT21	8		D
Dual Differential PECL/TTL Translator	ECL	MC100ELT23	–	8		D
Dual LVTTTL/LVCMOS to Differential PECL Translator	ECL	MC100LVLT22	–	8		D
Dual TTL/Differential PECL Translator	ECL	MC10ELT22	MC100ELT22	8		D
ECL/TTL Translator (Single P.S. @ + 5.0V)	ECL	MC10H350	–	16	P,L	FN
Hex ECL/MST Translator	ECL	MC10191	–	16	P,L	
Hex TTL OR CMOS/CMOS Hex Level Shifter	CMOS	MC14504B	–	16	P,L	D
Quad CMOS/ECL Translator (Single P.S. @ + 5.0V)	ECL	MC10H352	–	20	P,L	FN

## Selection by Function

Description	Tech.	Device(s)	Pins	DIP	SM
<b>TRANSLATORS</b>					
Quad MECL/TTL Translator	ECL	MC10H125	–	16	P,L FN
	ECL	MC10125	–	16	P,L FN
Quad MST/ECL Translator	ECL	MC10190	–	16	P
Quad TTL/ECL Translator (ECL Strobe)	ECL	MC10H424	–	16	P,L FN
Quad TTL/MECL Translator	ECL	MC10124	–	16	P,L FN
Quad TTL/MECL Translator, With TTL Strobe Input	ECL	MC10H124	–	16	P,L FN
Quad TTL/NMOS-to-PECL Translator (Single P.S. @+ 5.0V)	ECL	MC10H351	–	20	P,L FN
Registered Hex ECL/TTL Translator	ECL	MC10H605	MC100H605	28	FN
Registered Hex PECL/TTL Translator	ECL	MC10H607	MC100H607	28	FN
Registered Hex TTL/ECL Translator	ECL	MC10H604	MC100H604	28	FN
Registered Hex TTL/PECL Translator	ECL	MC10H606	MC100H606	28	FN
Triple MECL/NMOS Translator	ECL	MC10177	–	16	L
Triple ECL to PECL Translator	ECL	MC100LVEL90	MC100EL90	20	DW
Triple PECL to LVPECL Translator	ECL	MC100LVEL92	–	20	DW
Triple PECL to ECL Translator	ECL	MC100LVEL91	–	20	DW
TTL/Differential ECL Translator	ECL	MC10ELT24	MC100ELT24	8	D
TTL/Differential PECL Translator	ECL	MC10ELT20	MC100ELT20	8	D
TTL to Differential PECL/Differential PECL to TTL Translator	ECL	MC10ELT28	MC100ELT28	8	D
<b>VCO</b>					
Phase-Locked-Loop With VCO	CMOS	MC74HC4046A	–	16	N D
Low Power Voltage Controlled Oscillator Buffer	CMOS	MC12147	–	8	D,SD
Low Power Voltage Controlled Oscillator Buffer	CMOS	MC12149	–	8	D,SD

# Device Index

MC100E016	3.1-19	MC100EL07	3.1-26	MC100LVE210	3.1-13
MC100E101	3.1-27	MC100EL11	3.1-16	MC100LVE222	3.1-17
MC100E104	3.1-27	MC100EL12	3.1-29	MC100LVE310	3.1-13
MC100E107	3.1-27	MC100EL13	3.1-13	MC100LVEL01	3.1-26
MC100E111	3.1-16	MC100EL14	3.1-16	MC100LVEL11	3.1-13
MC100E112	3.1-29	MC100EL15	3.1-16	MC100LVEL13	3.1-13
MC100E116	3.1-35	MC100EL16	3.1-35	MC100LVEL14	3.1-16
MC100E122	3.1-29	MC100EL17	3.1-35	MC100LVEL16	3.1-35
MC100E131	3.1-22	MC100EL29	3.1-23	MC100LVEL17	3.1-35
MC100E136	3.1-18	MC100EL30	3.1-25	MC100LVEL29	3.1-23
MC100E137	3.1-19	MC100EL31	3.1-22	MC100LVEL30	3.1-25
MC100E141	3.1-37	MC100EL32	3.1-21	MC100LVEL31	3.1-24
MC100E142	3.1-37	MC100EL33	3.1-21	MC100LVEL32	3.1-21
MC100E143	3.1-22	MC100EL34	3.1-17	MC100LVEL33	3.1-21
MC100E150	3.1-30	MC100EL35	3.1-23	MC100LVEL38	3.1-17
MC100E151	3.1-22	MC100EL38	3.1-17	MC100LVEL39	3.1-17
MC100E154	3.1-30	MC100EL39	3.1-17	MC100LVEL51	3.1-22
MC100E155	3.1-30	MC100EL51	3.1-22	MC100LVEL56	3.1-32
MC100E156	3.1-30	MC100EL52	3.1-22	MC100LVEL59	3.1-33
MC100E157	3.1-33	MC100EL56	3.1-32	MC100LVEL90	3.1-39
MC100E158	3.1-31	MC100EL57	3.1-31	MC100LVEL91	3.1-39
MC100E160	3.1-34	MC100EL58	3.1-31	MC100LVEL92	3.1-39
MC100E163	3.1-31	MC100EL59	3.1-33	MC100LVELT22	3.1-38
MC100E164	3.1-31	MC100EL90	3.1-39	MC100SX1230	3.1-22
MC100E166	3.1-18	MC100ELT20	3.1-39	MC10100	3.1-28
MC100E167	3.1-22	MC100ELT21	3.1-38	MC10101	3.1-27
MC100E171	3.1-31	MC100ELT22	3.1-38	MC10102	3.1-28
MC100E175	3.1-30	MC100ELT23	3.1-38	MC10103	3.1-28
MC100E193	3.1-34	MC100ELT24	3.1-39	MC10104	3.1-25
MC100E195	3.1-35	MC100ELT25	3.1-38	MC10105	3.1-27
MC100E196	3.1-35	MC100ELT28	3.1-39	MC10106	3.1-28
MC100E210	3.1-13	MC100H600	3.1-38	MC10107	3.1-27
MC100E211	3.1-16	MC100H601	3.1-38	MC10109	3.1-27
MC100E212	3.1-36	MC100H602	3.1-38	MC10110	3.1-28
MC100E241	3.1-37	MC100H603	3.1-38	MC10111	3.1-28
MC100E256	3.1-30	MC100H604	3.1-39	MC10113	3.1-27
MC100E310	3.1-13	MC100H605	3.1-39	MC10114	3.1-36
MC100E336	3.1-14	MC100H606	3.1-39	MC10115	3.1-35
MC100E337	3.1-14	MC100H607	3.1-39	MC10116	3.1-36
MC100E404	3.1-27	MC100H640	3.1-17	MC10117	3.1-27
MC100E416	3.1-35	MC100H641	3.1-17	MC10118	3.1-27
MC100E431	3.1-22	MC100H642	3.1-17	MC10119	3.1-26
MC100E445	3.1-18	MC100H643	3.1-17	MC10121	3.1-26
MC100E446	3.1-18	MC100H644	3.1-17	MC10123	3.1-16
MC100E451	3.1-22	MC100H646	3.1-17	MC10124	3.1-39
MC100E452	3.1-22	MC100H660	3.1-31	MC10125	3.1-39
MC100E457	3.1-33	MC100H680	3.1-38	MC10128	3.1-14
MC100EL01	3.1-26	MC100H681	3.1-38	MC10129	3.1-35
MC100EL04	3.1-26	MC100LVE111	3.1-16	MC10130	3.1-30
MC100EL05	3.1-26	MC100LVE164	3.1-32	MC10131	3.1-23

## Device Index

MC10132	3.1-32	MC10E104	3.1-27	MC10EL11	3.1-16
MC10133	3.1-31	MC10E107	3.1-27	MC10EL12	3.1-29
MC10134	3.1-32	MC10E111	3.1-16	MC10EL15	3.1-16
MC10135	3.1-23	MC10E112	3.1-29	MC10EL16	3.1-35
MC10136	3.1-20	MC10E116	3.1-35	MC10EL31	3.1-22
MC10137	3.1-20	MC10E122	3.1-29	MC10EL32	3.1-21
MC10138	3.1-19	MC10E131	3.1-22	MC10EL33	3.1-21
MC10141	3.1-37	MC10E136	3.1-18	MC10EL34	3.1-17
MC10153	3.1-31	MC10E137	3.1-19	MC10EL35	3.1-23
MC10154	3.1-19	MC10E141	3.1-37	MC10EL51	3.1-22
MC10158	3.1-32	MC10E142	3.1-37	MC10EL52	3.1-22
MC10159	3.1-32	MC10E143	3.1-22	MC10EL57	3.1-31
MC1016	3.1-6	MC10E150	3.1-30	MC10EL58	3.1-31
MC10160	3.1-34	MC10E151	3.1-22	MC10EL89	3.1-21
MC10161	3.1-20	MC10E154	3.1-30	MC10ELT20	3.1-39
MC10162	3.1-20	MC10E155	3.1-30	MC10ELT21	3.1-38
MC10163	3.1-21	MC10E156	3.1-30	MC10ELT22	3.1-38
MC10164	3.1-31	MC10E157	3.1-33	MC10ELT24	3.1-39
MC10165	3.1-22	MC10E158	3.1-31	MC10ELT25	3.1-38
MC10166	3.1-18	MC10E160	3.1-34	MC10ELT28	3.1-39
MC10168	3.1-31	MC10E163	3.1-31	MC10H100	3.1-28
MC10170	3.1-34	MC10E164	3.1-31	MC10H101	3.1-27
MC10171	3.1-20	MC10E1651	3.1-18	MC10H102	3.1-28
MC10172	3.1-21	MC10E1652	3.1-18	MC10H103	3.1-28
MC10173	3.1-33	MC10E166	3.1-18	MC10H104	3.1-25
MC10174	3.1-32	MC10E167	3.1-22	MC10H105	3.1-27
MC10175	3.1-31	MC10E171	3.1-31	MC10H106	3.1-28
MC10176	3.1-23	MC10E175	3.1-30	MC10H107	3.1-27
MC10177	3.1-39	MC10E193	3.1-34	MC10H109	3.1-27
MC10178	3.1-19	MC10E195	3.1-35	MC10H113	3.1-27
MC10180	3.1-13	MC10E196	3.1-35	MC10H115	3.1-35
MC10181	3.1-13	MC10E197	3.1-31	MC10H116	3.1-36
MC10186	3.1-23	MC10E211	3.1-16	MC10H117	3.1-27
MC10188	3.1-29	MC10E212	3.1-36	MC10H118	3.1-27
MC10189	3.1-29	MC10E241	3.1-37	MC10H119	3.1-26
MC10190	3.1-39	MC10E256	3.1-30	MC10H121	3.1-26
MC10191	3.1-38	MC10E336	3.1-14	MC10H123	3.1-16
MC10192	3.1-16	MC10E337	3.1-14	MC10H124	3.1-39
MC10193	3.1-21	MC10E404	3.1-27	MC10H125	3.1-39
MC10195	3.1-29	MC10E411	3.1-16	MC10H130	3.1-30
MC10197	3.1-25	MC10E416	3.1-35	MC10H131	3.1-23
MC10198	3.1-33	MC10E431	3.1-22	MC10H135	3.1-23
MC10210	3.1-28	MC10E445	3.1-18	MC10H136	3.1-20
MC10211	3.1-28	MC10E446	3.1-18	MC10H141	3.1-37
MC10212	3.1-27	MC10E451	3.1-22	MC10H145	3.1-36
MC10216	3.1-35	MC10E452	3.1-22	MC10H158	3.1-33
MC10231	3.1-23	MC10E457	3.1-33	MC10H159	3.1-33
MC10804	3.1-38	MC10EL01	3.1-26	MC10H16	3.1-18
MC10805	3.1-38	MC10EL04	3.1-26	MC10H160	3.1-34
MC10E016	3.1-19	MC10EL05	3.1-26	MC10H161	3.1-20
MC10E101	3.1-27	MC10EL07	3.1-26	MC10H162	3.1-20

## Device Index

MC10H164	3.1-31	MC12014	3.1-19	MC12095	3.1-35
MC10H165	3.1-22	MC12015	3.1-35	MC12098	3.1-35
MC10H166	3.1-18	MC12016	3.1-35	MC12100	3.1-33
MC10H171	3.1-21	MC12017	3.1-35	MC12101	3.1-33
MC10H172	3.1-21	MC12018	3.1-35	MC12147	3.1-39
MC10H173	3.1-32	MC12019	3.1-35	MC12148	3.1-33
MC10H174	3.1-32	MC12022A	3.1-34	MC12149	3.1-39
MC10H175	3.1-31	MC12022B	3.1-34	MC12179	3.1-38
MC10H176	3.1-23	MC12022LVA	3.1-34	MC12181	3.1-38
MC10H179	3.1-13	MC12022LVB	3.1-34	MC12202	3.1-38
MC10H180	3.1-13	MC12022SLA	3.1-34	MC12206	3.1-38
MC10H181	3.1-13	MC12022SLB	3.1-34	MC12210	3.1-38
MC10H186	3.1-23	MC12022TSA	3.1-34	MC12429	3.1-17
MC10H188	3.1-29	MC12022TSB	3.1-34	MC12439	3.1-17
MC10H189	3.1-29	MC12022TVA	3.1-34	MC14000UB	3.1-28
MC10H209	3.1-27	MC12022TVB	3.1-34	MC14001B	3.1-28
MC10H210	3.1-28	MC12023	3.1-35	MC14001UB	3.1-28
MC10H211	3.1-28	MC12025	3.1-35	MC14002B	3.1-28
MC10H330	3.1-16	MC12026A	3.1-34	MC14002UB	3.1-28
MC10H332	3.1-14	MC12026B	3.1-34	MC14006B	3.1-36
MC10H334	3.1-16	MC12028A	3.1-34	MC14007UB	3.1-29
MC10H350	3.1-38	MC12028B	3.1-34	MC14008B	3.1-13
MC10H351	3.1-39	MC12031A	3.1-35	MC14011B	3.1-26
MC10H352	3.1-38	MC12031B	3.1-35	MC14011UB	3.1-26
MC10H423	3.1-16	MC12032A	3.1-35	MC14012B	3.1-25
MC10H424	3.1-39	MC12032B	3.1-35	MC14012UB	3.1-25
MC10H600	3.1-38	MC12033A	3.1-35	MC14013B	3.1-22
MC10H601	3.1-38	MC12033B	3.1-35	MC14014B	3.1-37
MC10H602	3.1-38	MC12034A	3.1-35	MC14015B	3.1-37
MC10H603	3.1-38	MC12034B	3.1-35	MC14016B	3.1-33
MC10H604	3.1-39	MC12036A	3.1-34	MC14017B	3.1-19
MC10H605	3.1-39	MC12036B	3.1-34	MC14018B	3.1-19
MC10H606	3.1-39	MC12038A	3.1-34	MC14020B	3.1-18
MC10H607	3.1-39	MC12040	3.1-21	MC14021B	3.1-37
MC10H640	3.1-17	MC12052A	3.1-34	MC14022B	3.1-19
MC10H641	3.1-17	MC12053A	3.1-34	MC14023B	3.1-26
MC10H642	3.1-17	MC12054A	3.1-35	MC14023UB	3.1-26
MC10H643	3.1-17	MC12058	3.1-34	MC14024B	3.1-18
MC10H644	3.1-17	MC12061	3.1-33	MC14025B	3.1-28
MC10H645	3.1-16	MC12066	3.1-34	MC14025UB	3.1-28
MC10H646	3.1-17	MC12073	3.1-34	MC14027B	3.1-23
MC10H660	3.1-31	MC12074	3.1-34	MC14028B	3.1-20
MC10H680	3.1-38	MC12075	3.1-34	MC14029B	3.1-19
MC10H681	3.1-38	MC12076	3.1-35	MC14035B	3.1-37
MC10SX1125	3.1-13	MC12078	3.1-35	MC14038B	3.1-13
MC10SX1130	3.1-17, 3.1-21	MC12079	3.1-35	MC14040B	3.1-18
MC10SX1189	3.1-17	MC12080	3.1-34	MC14042B	3.1-31
MC12002	3.1-21	MC12083	3.1-34	MC14043B	3.1-31
MC12009	3.1-35	MC12089	3.1-35	MC14044B	3.1-31
MC12011	3.1-35	MC12090	3.1-35	MC14046B	3.1-34
MC12013	3.1-35	MC12093	3.1-34	MC14049B	3.1-29

## Device Index

MC14049UB	3.1-29	MC14526B	3.1-19	MC4344	3.1-21
MC14050B	3.1-29	MC14527B	3.1-13	MC54HC00A	3.1-26
MC14051B	3.1-31	MC14528B	3.1-33	MC54HC02A	3.1-28
MC14052B	3.1-32	MC14529B	3.1-32	MC54HC04A	3.1-29
MC14053B	3.1-33	MC14530B	3.1-27	MC54HC08A	3.1-25
MC14060B	3.1-18	MC14531B	3.1-34	MC54HC132A	3.1-36
MC14066B	3.1-33	MC14532B	3.1-21	MC54HC138A	3.1-20
MC14067B	3.1-31	MC14534B	3.1-18	MC54HC139A	3.1-21
MC14068B	3.1-25	MC14536B	3.1-34	MC54HC14A	3.1-36
MC14069UB	3.1-29	MC14538B	3.1-33	MC54HC154	3.1-20
MC14070B	3.1-27	MC14539B	3.1-32	MC54HC157A	3.1-32
MC14071B	3.1-28	MC14541B	3.1-34	MC54HC158	3.1-32
MC14072B	3.1-28	MC14543B	3.1-21	MC54HC160	3.1-19
MC14073B	3.1-26	MC14544B	3.1-21	MC54HC161A	3.1-19
MC14075B	3.1-29	MC14547B	3.1-21	MC54HC162	3.1-19
MC14076B	3.1-25	MC14549B	3.1-38	MC54HC163A	3.1-19
MC14077B	3.1-27	MC14551B	3.1-32	MC54HC164	3.1-37
MC14078B	3.1-28	MC14553B	3.1-18	MC54HC164A	3.1-37
MC14081B	3.1-25	MC14555B	3.1-21	MC54HC165	3.1-37
MC14082B	3.1-25	MC14556B	3.1-21	MC54HC174A	3.1-23
MC14093B	3.1-36	MC14557B	3.1-36	MC54HC175	3.1-25
MC14094B	3.1-37	MC14558B	3.1-21	MC54HC175A	3.1-25
MC14099B	3.1-30	MC14559B	3.1-38	MC54HC240A	3.1-15
MC14106B	3.1-36	MC14560B	3.1-13	MC54HC241A	3.1-15
MC14161B	3.1-18	MC14561B	3.1-13	MC54HC244A	3.1-16
MC14163B	3.1-18	MC14562B	3.1-36	MC54HC245A	3.1-16
MC14174B	3.1-23	MC14566B	3.1-19	MC54HC251	3.1-31
MC14175B	3.1-25	MC14568B	3.1-19	MC54HC259	3.1-20
MC14194B	3.1-37	MC14569B	3.1-19	MC54HC27	3.1-28
MC14415	3.1-34	MC14572UB	3.1-27	MC54HC273A	3.1-24
MC14490	3.1-13	MC14580B	3.1-36	MC54HC32A	3.1-28
MC14500B	3.1-29	MC14583B	3.1-36	MC54HC354	3.1-31
MC14501UB	3.1-27	MC14584B	3.1-36	MC54HC365	3.1-14
MC14502B	3.1-29	MC14585B	3.1-17	MC54HC366	3.1-14
MC14503B	3.1-14	MC14598B	3.1-30	MC54HC367	3.1-14
MC14504B	3.1-38	MC14599B	3.1-30	MC54HC373A	3.1-31
MC14506UB	3.1-27	MC1648	3.1-34	MC54HC374A	3.1-24
MC14508B	3.1-30	MC1650	3.1-18	MC54HC390	3.1-19
MC14510B	3.1-19	MC1651	3.1-18	MC54HC393	3.1-19
MC14511B	3.1-21	MC1658	3.1-33	MC54HC4016	3.1-33
MC14512B	3.1-31	MC1660	3.1-27	MC54HC4040A	3.1-18
MC14513B	3.1-21	MC1662	3.1-28	MC54HC4049	3.1-29
MC14514B	3.1-20	MC1670	3.1-24	MC54HC4050	3.1-29
MC14515B	3.1-20	MC1672	3.1-27	MC54HC4051	3.1-31
MC14516B	3.1-19	MC1692	3.1-35	MC54HC4053	3.1-33
MC14517B	3.1-38	MC4016	3.1-20	MC54HC4060	3.1-18
MC14518B	3.1-19	MC4018	3.1-20	MC54HC4060A	3.1-18
MC14519B	3.1-26	MC4024	3.1-33	MC54HC4066	3.1-33
MC14520B	3.1-19	MC4044	3.1-21	MC54HC4351	3.1-31
MC14521B	3.1-34	MC4316	3.1-20	MC54HC4353	3.1-33
MC14522B	3.1-19	MC4324	3.1-33	MC54HC4538A	3.1-33

## Device Index

MC54HC533A	3.1-31	MC74AC10	3.1-26	MC74AC563	3.1-30
MC54HC534A	3.1-24	MC74AC109	3.1-23	MC74AC564	3.1-24
MC54HC540A	3.1-15	MC74AC11	3.1-26	MC74AC573	3.1-30
MC54HC541A	3.1-15	MC74AC112	3.1-23	MC74AC574	3.1-24
MC54HC563A	3.1-31	MC74AC113	3.1-23	MC74AC620	3.1-14
MC54HC573A	3.1-31	MC74AC125	3.1-16	MC74AC623	3.1-14
MC54HC574A	3.1-24	MC74AC126	3.1-16	MC74AC640	3.1-14
MC54HC589	3.1-37	MC74AC132	3.1-36	MC74AC643	3.1-14
MC54HC589A	3.1-37	MC74AC138	3.1-20	MC74AC646	3.1-15
MC54HC595A	3.1-37	MC74AC139	3.1-21	MC74AC648	3.1-15
MC54HC597	3.1-37	MC74AC14	3.1-36	MC74AC652	3.1-15
MC54HC597A	3.1-37	MC74AC151	3.1-31	MC74AC74	3.1-22
MC54HC640A	3.1-15	MC74AC153	3.1-32	MC74AC810	3.1-27
MC54HC646	3.1-16	MC74AC157	3.1-33	MC74AC86	3.1-27
MC54HC688	3.1-18	MC74AC158	3.1-33	MC74ACT00	3.1-26
MC54HC74A	3.1-23	MC74AC160	3.1-20	MC74ACT02	3.1-28
MC54HC86	3.1-27	MC74AC161	3.1-20	MC74ACT04	3.1-29
MC54HC86A	3.1-27	MC74AC162	3.1-20	MC74ACT05	3.1-29
MC54HCT00A	3.1-26	MC74AC163	3.1-20	MC74ACT08	3.1-25
MC54HCT08A	3.1-25	MC74AC174	3.1-23	MC74ACT10	3.1-26
MC54HCT14A	3.1-36	MC74AC175	3.1-24	MC74ACT109	3.1-23
MC54HCT161A	3.1-19	MC74AC190	3.1-20	MC74ACT11	3.1-26
MC54HCT163A	3.1-19	MC74AC194	3.1-37	MC74ACT112	3.1-23
MC54HCT241A	3.1-15	MC74AC20	3.1-25	MC74ACT113	3.1-23
MC54HCT244A	3.1-15	MC74AC240	3.1-15	MC74ACT125	3.1-16
MC54HCT245A	3.1-14	MC74AC241	3.1-15	MC74ACT126	3.1-16
MC54HCT32A	3.1-28	MC74AC244	3.1-15	MC74ACT132	3.1-36
MC54HCT373A	3.1-30	MC74AC245	3.1-14	MC74ACT138	3.1-20
MC54HCT374A	3.1-24	MC74AC251	3.1-31	MC74ACT139	3.1-21
MC54HCT574A	3.1-24	MC74AC253	3.1-32	MC74ACT14	3.1-36
MC660	3.1-22	MC74AC256	3.1-30	MC74ACT151	3.1-31
MC661	3.1-22	MC74AC257	3.1-32	MC74ACT153	3.1-32
MC662	3.1-22	MC74AC258	3.1-32	MC74ACT157	3.1-33
MC663	3.1-23	MC74AC259	3.1-30	MC74ACT158	3.1-33
MC664	3.1-24	MC74AC273	3.1-24	MC74ACT160	3.1-20
MC667	3.1-33	MC74AC299	3.1-37	MC74ACT161	3.1-20
MC668	3.1-29	MC74AC32	3.1-28	MC74ACT162	3.1-20
MC669	3.1-22	MC74AC323	3.1-37	MC74ACT163	3.1-20
MC670	3.1-29	MC74AC350	3.1-37	MC74ACT174	3.1-23
MC671	3.1-29	MC74AC352	3.1-32	MC74ACT175	3.1-24
MC672	3.1-29	MC74AC353	3.1-32	MC74ACT194	3.1-37
MC677	3.1-29	MC74AC373	3.1-30	MC74ACT20	3.1-25
MC678	3.1-29	MC74AC374	3.1-24	MC74ACT240	3.1-15
MC68150*33	3.1-14	MC74AC377	3.1-24	MC74ACT241	3.1-15
MC68150*40	3.1-14	MC74AC378	3.1-22	MC74ACT244	3.1-15
MC68194	3.1-16	MC74AC4020	3.1-18	MC74ACT245	3.1-14
MC74AC00	3.1-26	MC74AC4040	3.1-18	MC74ACT251	3.1-31
MC74AC02	3.1-28	MC74AC533	3.1-30	MC74ACT253	3.1-32
MC74AC04	3.1-29	MC74AC534	3.1-24	MC74ACT256	3.1-30
MC74AC05	3.1-29	MC74AC540	3.1-15	MC74ACT257	3.1-32
MC74AC08	3.1-25	MC74AC541	3.1-15	MC74ACT258	3.1-32



## Device Index

MC74ACT259	3.1-30
MC74ACT273	3.1-24
MC74ACT299	3.1-37
MC74ACT32	3.1-28
MC74ACT323	3.1-37
MC74ACT350	3.1-37
MC74ACT352	3.1-32
MC74ACT353	3.1-32
MC74ACT373	3.1-30
MC74ACT374	3.1-24
MC74ACT377	3.1-24
MC74ACT378	3.1-22
MC74ACT521	3.1-18
MC74ACT533	3.1-30
MC74ACT534	3.1-24
MC74ACT540	3.1-15
MC74ACT541	3.1-15
MC74ACT563	3.1-30
MC74ACT564	3.1-24
MC74ACT573	3.1-30
MC74ACT574	3.1-24
MC74ACT620	3.1-14
MC74ACT623	3.1-14
MC74ACT640	3.1-14
MC74ACT643	3.1-14
MC74ACT646	3.1-15
MC74ACT648	3.1-15
MC74ACT652	3.1-15
MC74ACT74	3.1-22
MC74ACT810	3.1-27
MC74ACT86	3.1-27
MC74F00	3.1-26
MC74F02	3.1-28
MC74F04	3.1-29
MC74F08	3.1-25
MC74F10	3.1-26
MC74F109	3.1-23
MC74F11	3.1-26
MC74F112	3.1-23
MC74F1245	3.1-14
MC74F125	3.1-16
MC74F126	3.1-16
MC74F13	3.1-36
MC74F132	3.1-36
MC74F138	3.1-20
MC74F139	3.1-21
MC74F14	3.1-36
MC74F148	3.1-22
MC74F151	3.1-31
MC74F153	3.1-32
MC74F157A	3.1-32

MC74F158A	3.1-32
MC74F160A	3.1-19
MC74F161A	3.1-19
MC74F162A	3.1-19
MC74F163A	3.1-19
MC74F164	3.1-37
MC74F168	3.1-18
MC74F169	3.1-18
MC74F174	3.1-23
MC74F175	3.1-24
MC74F1803	3.1-17
MC74F181	3.1-13
MC74F182	3.1-13
MC74F194	3.1-37
MC74F195	3.1-37
MC74F20	3.1-25
MC74F21	3.1-25
MC74F2245	3.1-38
MC74F240	3.1-15
MC74F241	3.1-15
MC74F242	3.1-16
MC74F243	3.1-16
MC74F244	3.1-15
MC74F245	3.1-14
MC74F251	3.1-31
MC74F253	3.1-32
MC74F256	3.1-30
MC74F257A	3.1-33
MC74F258A	3.1-33
MC74F259	3.1-30
MC74F269	3.1-18
MC74F280	3.1-34
MC74F283	3.1-13
MC74F299	3.1-37
MC74F32	3.1-28
MC74F323	3.1-37
MC74F350	3.1-37
MC74F352	3.1-32
MC74F353	3.1-32
MC74F365	3.1-14
MC74F366	3.1-14
MC74F367	3.1-14
MC74F368	3.1-14
MC74F37	3.1-25
MC74F373	3.1-30
MC74F374	3.1-24
MC74F377	3.1-24
MC74F378	3.1-36
MC74F379	3.1-25
MC74F38	3.1-26
MC74F381	3.1-13

MC74F382	3.1-13
MC74F3893A	3.1-38
MC74F398	3.1-33
MC74F399	3.1-33
MC74F40	3.1-25
MC74F51	3.1-27
MC74F521	3.1-18
MC74F533	3.1-30
MC74F534	3.1-24
MC74F537	3.1-20
MC74F538	3.1-20
MC74F539	3.1-20
MC74F543	3.1-15
MC74F544	3.1-15
MC74F568	3.1-18
MC74F569	3.1-18
MC74F574	3.1-24
MC74F579	3.1-19
MC74F620	3.1-15
MC74F623	3.1-15
MC74F64	3.1-26
MC74F640	3.1-15
MC74F646	3.1-15
MC74F657A	3.1-14
MC74F657B	3.1-14
MC74F74	3.1-23
MC74F779	3.1-19
MC74F803	3.1-17
MC74F823	3.1-14
MC74F827	3.1-14
MC74F828	3.1-14
MC74F85	3.1-17
MC74F86	3.1-27
MC74HC00A	3.1-26
MC74HC02A	3.1-28
MC74HC03A	3.1-26
MC74HC04A	3.1-29
MC74HC08A	3.1-25
MC74HC10	3.1-26
MC74HC107	3.1-23
MC74HC109	3.1-23
MC74HC11	3.1-26
MC74HC112	3.1-23
MC74HC125A	3.1-16
MC74HC126A	3.1-16
MC74HC132A	3.1-36
MC74HC133	3.1-25
MC74HC137	3.1-20
MC74HC138A	3.1-20
MC74HC139A	3.1-21
MC74HC147	3.1-22

## Device Index

MC74HC14A	3.1-36
MC74HC151	3.1-31
MC74HC153	3.1-32
MC74HC154	3.1-20
MC74HC157A	3.1-32
MC74HC158	3.1-32
MC74HC158A	3.1-32
MC74HC160	3.1-19
MC74HC161A	3.1-19
MC74HC162	3.1-19
MC74HC163	3.1-19
MC74HC164	3.1-37
MC74HC164A	3.1-37
MC74HC165	3.1-37
MC74HC173	3.1-25
MC74HC174A	3.1-23
MC74HC175	3.1-25
MC74HC175A	3.1-25
MC74HC194	3.1-37
MC74HC195	3.1-37
MC74HC20	3.1-25
MC74HC237	3.1-20
MC74HC240A	3.1-15
MC74HC241A	3.1-15
MC74HC242	3.1-16
MC74HC244A	3.1-16
MC74HC245A	3.1-16
MC74HC251	3.1-31
MC74HC253	3.1-32
MC74HC257	3.1-32
MC74HC259	3.1-20
MC74HC27	3.1-28
MC74HC273A	3.1-24
MC74HC280	3.1-34
MC74HC299	3.1-37
MC74HC30	3.1-25
MC74HC32A	3.1-28
MC74HC354	3.1-31
MC74HC365	3.1-14
MC74HC366	3.1-14
MC74HC367	3.1-14
MC74HC368	3.1-14
MC74HC373A	3.1-31
MC74HC374A	3.1-24
MC74HC390	3.1-19
MC74HC393	3.1-19
MC74HC4002	3.1-28
MC74HC4016	3.1-33
MC74HC4017	3.1-19
MC74HC4020A	3.1-18
MC74HC4024	3.1-33

MC74HC4040A	3.1-18
MC74HC4046A	3.1-39
MC74HC4049	3.1-29
MC74HC4050	3.1-29
MC74HC4051	3.1-31
MC74HC4052	3.1-32
MC74HC4053	3.1-33
MC74HC4060	3.1-18
MC74HC4060A	3.1-18
MC74HC4066	3.1-33
MC74HC4075	3.1-29
MC74HC4078	3.1-27
MC74HC42	3.1-20
MC74HC4316	3.1-33
MC74HC4351	3.1-31
MC74HC4353	3.1-33
MC74HC4511	3.1-21
MC74HC4514	3.1-20
MC74HC4538A	3.1-33
MC74HC4851A	3.1-31
MC74HC4852A	3.1-31
MC74HC4853A	3.1-31
MC74HC51	3.1-26
MC74HC533A	3.1-31
MC74HC534A	3.1-24
MC74HC540A	3.1-15
MC74HC541A	3.1-15
MC74HC563A	3.1-31
MC74HC564A	3.1-24
MC74HC573A	3.1-31
MC74HC574A	3.1-24
MC74HC58	3.1-26
MC74HC589	3.1-37
MC74HC589A	3.1-37
MC74HC595A	3.1-37
MC74HC597	3.1-37
MC74HC597A	3.1-37
MC74HC640A	3.1-15
MC74HC646	3.1-16
MC74HC688	3.1-18
MC74HC7266	3.1-27
MC74HC7266A	3.1-27
MC74HC73	3.1-23
MC74HC74A	3.1-23
MC74HC75	3.1-30
MC74HC76	3.1-23
MC74HC85	3.1-17
MC74HC86	3.1-27
MC74HC86A	3.1-27
MC74HCT00A	3.1-26
MC74HCT04A	3.1-29

MC74HCT08A	3.1-25
MC74HCT138A	3.1-20
MC74HCT14A	3.1-36
MC74HCT157A	3.1-32
MC74HCT161A	3.1-19
MC74HCT163A	3.1-19
MC74HCT174A	3.1-23
MC74HCT240A	3.1-15
MC74HCT241A	3.1-15
MC74HCT244A	3.1-15
MC74HCT245A	3.1-14
MC74HCT273A	3.1-24
MC74HCT32A	3.1-28
MC74HCT373A	3.1-30
MC74HCT374A	3.1-24
MC74HCT541A	3.1-15
MC74HCT573A	3.1-31
MC74HCT574A	3.1-24
MC74HCT74A	3.1-23
MC74HCU04	3.1-29
MC74LCX00	3.1-25
MC74LCX02	3.1-28
MC74LCX04	3.1-29
MC74LCX08	3.1-25
MC74LCX125	3.1-13
MC74LCX138	3.1-21
MC74LCX16240A	3.1-13
MC74LCX16244	3.1-13
MC74LCX16245	3.1-38
MC74LCX16373	3.1-30
MC74LCX373	3.1-30
MC74LCX16374	3.1-24
MC74LCX16543A	3.1-38
MC74LCX240	3.1-13
MC74LCX244	3.1-13
MC74LCX245	3.1-38
MC74LCX32	3.1-28
MC74LCX374	3.1-24
MC74LCX540	3.1-13
MC74LCX541	3.1-13
MC74LCX573	3.1-30
MC74LCX574	3.1-24
MC74LCX86	3.1-27
MC74LVQ00	3.1-25
MC74LVQ04	3.1-29
MC74LVQ125	3.1-14
MC74LVQ138	3.1-21
MC74LVQ240	3.1-14
MC74LVQ244	3.1-13
MC74LVQ245	3.1-38
MC74LVQ32	3.1-28

## Device Index

MC74LVQ373	3.1-30	MCM10149*25	3.1-35	SN54LS133	3.1-25
MC74LVQ374	3.1-24	MCM10152	3.1-35	SN54LS137	3.1-20
MC74LVQ541	3.1-13	MPA1000	3.1-6, 3.1-7	SN54LS138	3.1-20
MC74LVQ573	3.1-30	MPA1016	3.1-5, 3.1-22	SN54LS139	3.1-21
MC74LVQ574	3.1-24	MPA1036	3.1-5, 3.1-6, 3.1-22	SN54LS14	3.1-36
MC74LVQ646	3.1-38	MPA1064	3.1-5, 3.1-6, 3.1-22	SN54LS145	3.1-20
MC74LVQ652	3.1-38	MPA1100	3.1-5, 3.1-6, 3.1-22	SN54LS147	3.1-21
MC830	3.1-25	MPA17000	3.1-11	SN54LS148	3.1-22
MC832	3.1-13	MPA17128	3.1-11, 3.1-36	SN54LS15	3.1-26
MC836	3.1-29	MPA1765	3.1-11, 3.1-36	SN54LS151	3.1-31
MC837	3.1-29	MPC903	3.1-16	SN54LS153	3.1-32
MC840	3.1-29	MPC904	3.1-16	SN54LS155	3.1-20
MC844	3.1-22	MPC905	3.1-16	SN54LS156	3.1-20
MC845	3.1-22	MPC911	3.1-17	SN54LS157	3.1-32
MC846	3.1-26	MPC9159-410	3.1-17	SN54LS158	3.1-32
MC849	3.1-26	MPC930	3.1-17	SN54LS160A	3.1-18
MC88913	3.1-17	MPC931	3.1-17	SN54LS161A	3.1-18
MC88914	3.1-17	MPC946	3.1-17	SN54LS162A	3.1-18
MC88915*55	3.1-17	MPC947	3.1-16	SN54LS163A	3.1-18
MC88915*70	3.1-17	MPC948	3.1-16	SN54LS164	3.1-37
MC88915T*100	3.1-17	MPC949	3.1-17	SN54LS165	3.1-37
MC88915T*133	3.1-17	MPC950	3.1-17	SN54LS166	3.1-37
MC88915T*160	3.1-17	MPC951	3.1-17	SN54LS168	3.1-19
MC88915T*55	3.1-17	MPC952	3.1-17	SN54LS169	3.1-19
MC88915T*70	3.1-17	MPC956	3.1-17	SN54LS170	3.1-36
MC88916*70	3.1-17	MPC970	3.1-17	SN54LS173A	3.1-22
MC88916*80	3.1-17	MPC974	3.1-16	SN54LS174	3.1-23
MC88920	3.1-16	MPC980	3.1-17	SN54LS175	3.1-25
MC88921	3.1-16	MPC992	3.1-17	SN54LS181	3.1-13
MC88LV926	3.1-17	SN54LS00	3.1-26	SN54LS190	3.1-19
MC88PL117	3.1-17	SN54LS01	3.1-26	SN54LS191	3.1-19
MC936	3.1-29	SN54LS02	3.1-28	SN54LS192	3.1-19
MC937	3.1-29	SN54LS03	3.1-26	SN54LS193	3.1-19
MC944	3.1-22	SN54LS04	3.1-29	SN54LS194A	3.1-37
MC945	3.1-22	SN54LS05	3.1-29	SN54LS195A	3.1-38
MC946	3.1-26	SN54LS08	3.1-25	SN54LS196	3.1-18
MC951	3.1-33	SN54LS09	3.1-25	SN54LS197	3.1-18
MC952	3.1-23	SN54LS10	3.1-26	SN54LS20	3.1-25
MC953	3.1-23	SN54LS107A	3.1-23	SN54LS21	3.1-25
MCCS142233	3.1-36	SN54LS109A	3.1-23	SN54LS22	3.1-25
MCCS142234	3.1-36	SN54LS11	3.1-26	SN54LS221	3.1-33
MCCS142235	3.1-36	SN54LS112A	3.1-23	SN54LS240	3.1-15
MCCS142236	3.1-36	SN54LS113A	3.1-23	SN54LS241	3.1-15
MCCS142237	3.1-36	SN54LS114A	3.1-23	SN54LS242	3.1-16
MCCS142238	3.1-36	SN54LS12	3.1-26	SN54LS243	3.1-16
MCH12140	3.1-21	SN54LS122	3.1-33	SN54LS244	3.1-15
MCK12140	3.1-21	SN54LS123	3.1-33	SN54LS245	3.1-15
MCM10139	3.1-35	SN54LS125A	3.1-16	SN54LS247	3.1-21
MCM10143	3.1-36	SN54LS126A	3.1-16	SN54LS248	3.1-21
MCM10145	3.1-36	SN54LS13	3.1-36	SN54LS249	3.1-21
MCM10146	3.1-35	SN54LS132	3.1-36	SN54LS251	3.1-31

## Device Index

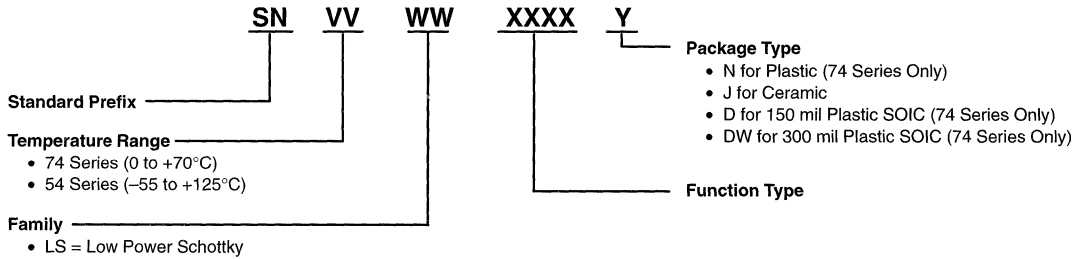
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SN54LS256	3.1-30	SN54LS55	3.1-26	SN74LS132	3.1-36
SN54LS257B	3.1-32	SN54LS569A	3.1-18	SN74LS133	3.1-25
SN54LS258B	3.1-33	SN54LS623	3.1-15	SN74LS136	3.1-27
SN54LS259	3.1-30	SN54LS640	3.1-15	SN74LS137	3.1-20
SN54LS26	3.1-25	SN54LS641	3.1-38	SN74LS138	3.1-20
SN54LS260	3.1-28	SN54LS642	3.1-38	SN74LS139	3.1-21
SN54LS266	3.1-27	SN54LS645	3.1-15	SN74LS14	3.1-36
SN54LS27	3.1-28	SN54LS669	3.1-20	SN74LS145	3.1-20
SN54LS273	3.1-24	SN54LS670	3.1-36	SN74LS147	3.1-21
SN54LS279	3.1-31	SN54LS682	3.1-18	SN74LS148	3.1-22
SN54LS28	3.1-28	SN54LS684	3.1-18	SN74LS15	3.1-26
SN54LS280	3.1-34	SN54LS688	3.1-18	SN74LS151	3.1-31
SN54LS283	3.1-13	SN54LS73A	3.1-23	SN74LS153	3.1-32
SN54LS290	3.1-19	SN54LS748	3.1-22	SN74LS155	3.1-20
SN54LS293	3.1-18	SN54LS74A	3.1-23	SN74LS156	3.1-20
SN54LS298	3.1-32	SN54LS75	3.1-30	SN74LS157	3.1-32
SN54LS299	3.1-37	SN54LS76A	3.1-23	SN74LS158	3.1-32
SN54LS30	3.1-25	SN54LS77	3.1-30	SN74LS160A	3.1-18
SN54LS32	3.1-28	SN54LS795	3.1-14	SN74LS161A	3.1-18
SN54LS322A	3.1-37	SN54LS796	3.1-14	SN74LS162A	3.1-18
SN54LS323	3.1-37	SN54LS797	3.1-14	SN74LS163A	3.1-18
SN54LS33	3.1-28	SN54LS798	3.1-14	SN74LS164	3.1-37
SN54LS348	3.1-22	SN54LS83A	3.1-13	SN74LS165	3.1-37
SN54LS352	3.1-32	SN54LS848	3.1-22	SN74LS166	3.1-37
SN54LS353	3.1-32	SN54LS85	3.1-17	SN74LS168	3.1-19
SN54LS365A	3.1-14	SN54LS86	3.1-27	SN74LS169	3.1-19
SN54LS366A	3.1-14	SN54LS90	3.1-19	SN74LS170	3.1-36
SN54LS367A	3.1-14	SN54LS92	3.1-19	SN74LS173A	3.1-22
SN54LS368A	3.1-14	SN54LS93	3.1-18	SN74LS174	3.1-23
SN54LS37	3.1-25	SN54LS95B	3.1-37	SN74LS175	3.1-25
SN54LS373	3.1-30	SN74LS00	3.1-26	SN74LS181	3.1-13
SN54LS374	3.1-24	SN74LS01	3.1-26	SN74LS190	3.1-19
SN54LS375	3.1-30	SN74LS02	3.1-28	SN74LS191	3.1-19
SN54LS377	3.1-24	SN74LS03	3.1-26	SN74LS192	3.1-19
SN54LS378	3.1-23	SN74LS04	3.1-29	SN74LS193	3.1-19
SN54LS379	3.1-22	SN74LS05	3.1-29	SN74LS194A	3.1-37
SN54LS38	3.1-26	SN74LS08	3.1-25	SN74LS195A	3.1-38
SN54LS386	3.1-27	SN74LS09	3.1-25	SN74LS196	3.1-18
SN54LS390	3.1-19	SN74LS10	3.1-26	SN74LS197	3.1-18
SN54LS393	3.1-19	SN74LS107A	3.1-23	SN74LS20	3.1-25
SN54LS398	3.1-33	SN74LS109A	3.1-23	SN74LS21	3.1-25
SN54LS399	3.1-33	SN74LS11	3.1-26	SN74LS22	3.1-25
SN54LS40	3.1-25	SN74LS112A	3.1-23	SN74LS221	3.1-33
SN54LS42	3.1-20	SN74LS113A	3.1-23	SN74LS240	3.1-15
SN54LS47	3.1-21	SN74LS114A	3.1-23	SN74LS241	3.1-15
SN54LS48	3.1-21	SN74LS12	3.1-26	SN74LS242	3.1-16
SN54LS490	3.1-19	SN74LS122	3.1-33	SN74LS243	3.1-16
SN54LS51	3.1-27	SN74LS123	3.1-33	SN74LS244	3.1-15
SN54LS54	3.1-26	SN74LS125A	3.1-16	SN74LS245	3.1-15
SN54LS540	3.1-15	SN74LS126A	3.1-16	SN74LS247	3.1-21

## Device Index

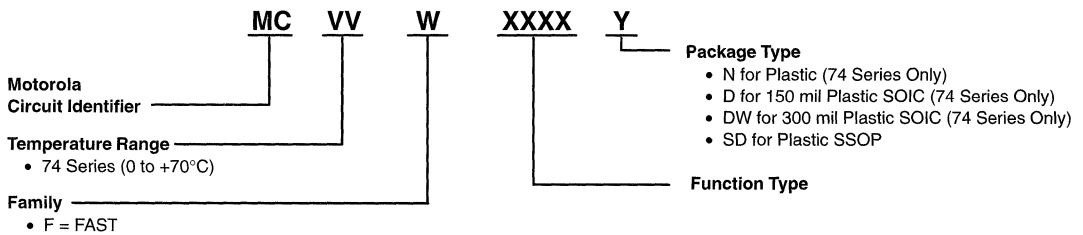
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SN74LS251	3.1-31	SN74LS368A	3.1-14	SN74LS641	3.1-38
SN74LS253	3.1-32	SN74LS37	3.1-25	SN74LS642	3.1-38
SN74LS257B	3.1-32	SN74LS373	3.1-30	SN74LS645	3.1-15
SN74LS258B	3.1-33	SN74LS374	3.1-24	SN74LS669	3.1-20
SN74LS259	3.1-30	SN74LS375	3.1-30	SN74LS670	3.1-36
SN74LS26	3.1-25	SN74LS377	3.1-24	SN74LS682	3.1-18
SN74LS260	3.1-28	SN74LS378	3.1-23	SN74LS684	3.1-18
SN74LS266	3.1-27	SN74LS379	3.1-22	SN74LS688	3.1-18
SN74LS27	3.1-28	SN74LS38	3.1-26	SN74LS73A	3.1-23
SN74LS273	3.1-24	SN74LS386	3.1-27	SN74LS748	3.1-22
SN74LS279	3.1-31	SN74LS390	3.1-19	SN74LS74A	3.1-23
SN74LS28	3.1-28	SN74LS393	3.1-19	SN74LS75	3.1-30
SN74LS280	3.1-34	SN74LS395	3.1-37	SN74LS76A	3.1-23
SN74LS283	3.1-13	SN74LS398	3.1-33	SN74LS77	3.1-30
SN74LS290	3.1-19	SN74LS399	3.1-33	SN74LS795	3.1-14
SN74LS293	3.1-18	SN74LS40	3.1-25	SN74LS796	3.1-14
SN74LS298	3.1-32	SN74LS42	3.1-20	SN74LS797	3.1-14
SN74LS299	3.1-37	SN74LS47	3.1-21	SN74LS798	3.1-14
SN74LS30	3.1-25	SN74LS48	3.1-21	SN74LS83A	3.1-13
SN74LS32	3.1-28	SN74LS490	3.1-19	SN74LS848	3.1-22
SN74LS322A	3.1-37	SN74LS51	3.1-27	SN74LS85	3.1-17
SN74LS323	3.1-37	SN74LS54	3.1-26	SN74LS86	3.1-27
SN74LS33	3.1-28	SN74LS540	3.1-15	SN74LS90	3.1-19
SN74LS348	3.1-22	SN74LS541	3.1-15	SN74LS92	3.1-19
SN74LS352	3.1-32	SN74LS55	3.1-26	SN74LS93	3.1-18
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SN74LS365A	3.1-14				

# Ordering Information Device Nomenclatures

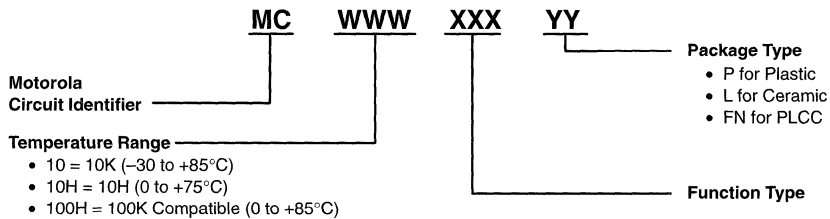
## LS – Low Power Schottky



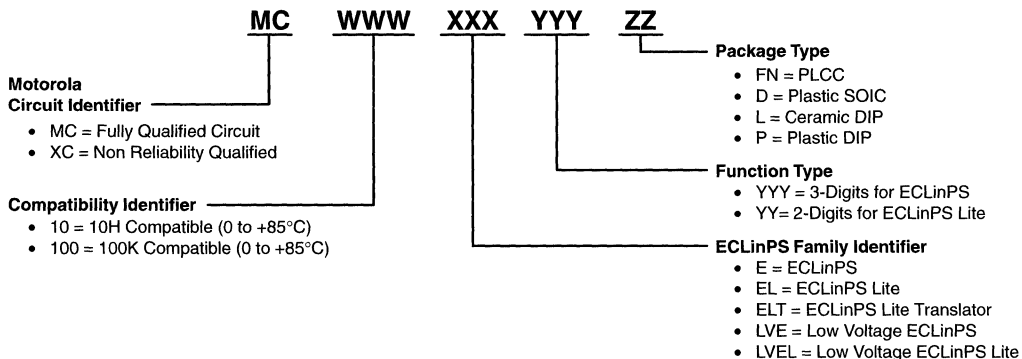
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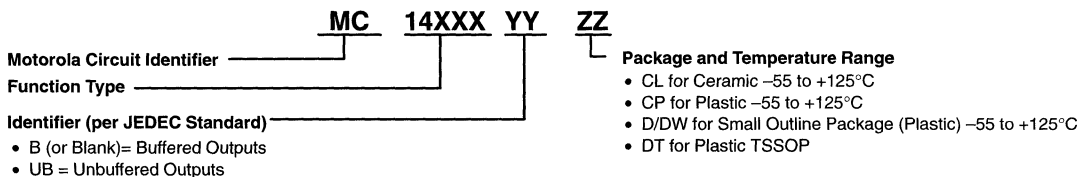
## MECL 10K, MECL 10H/100H



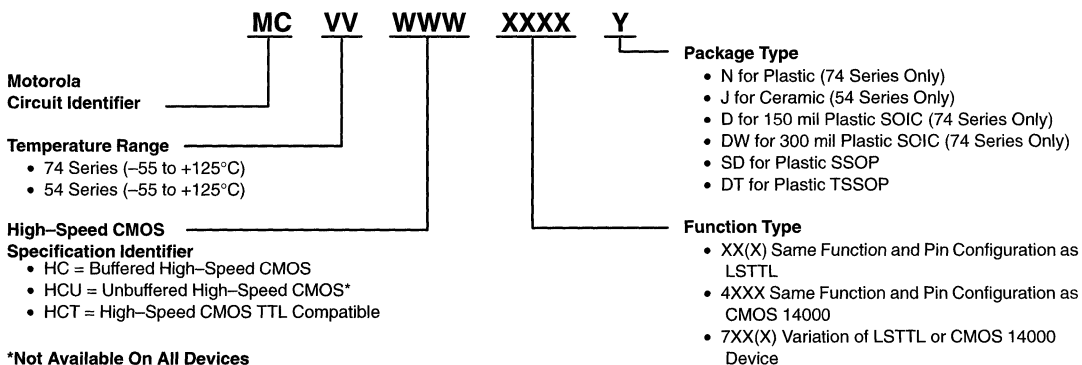
## ECLinPS, ECLinPS Lite



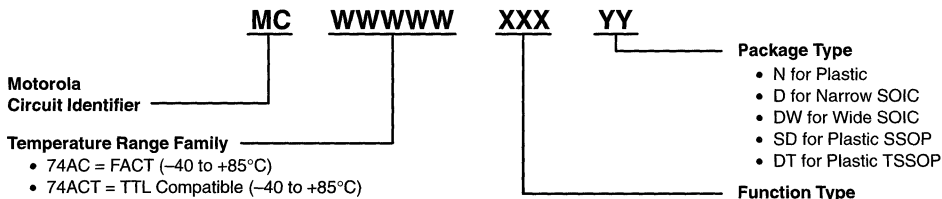
## Metal Gate 14000 Series CMOS



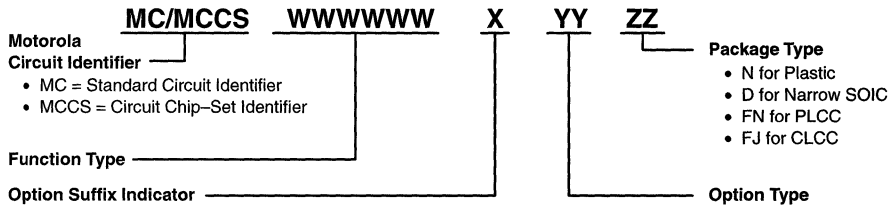
## High-Speed CMOS



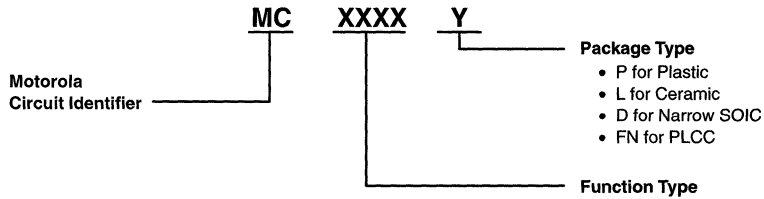
## FACT



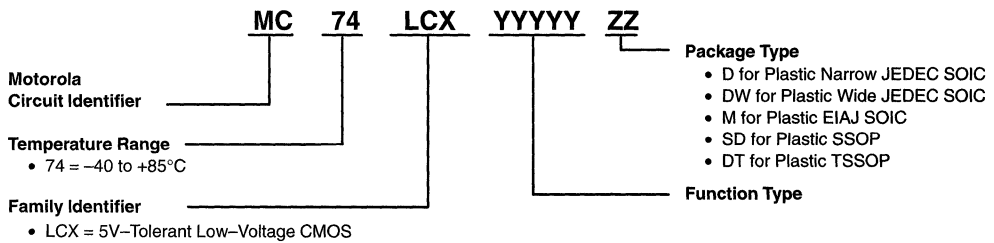
## Other Logic Circuits



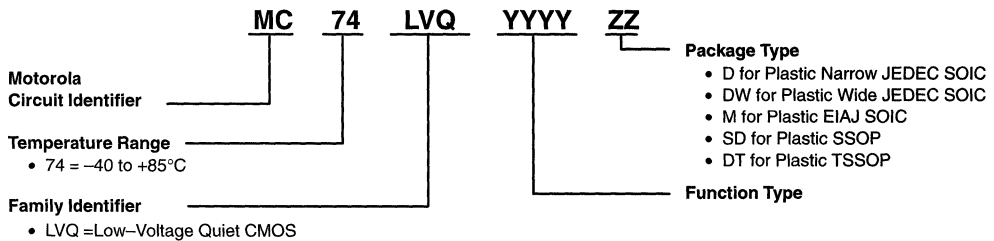
## MECL III/HTL/DTL



## LCX Products



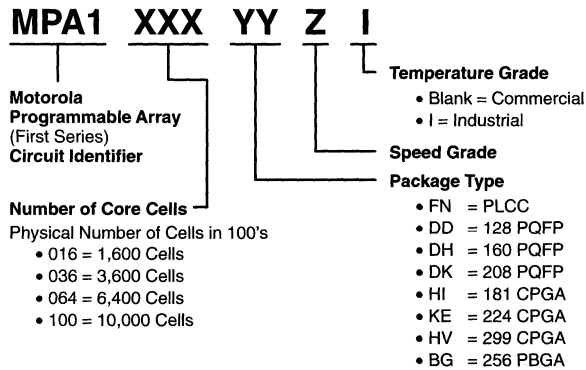
## LVQ Products



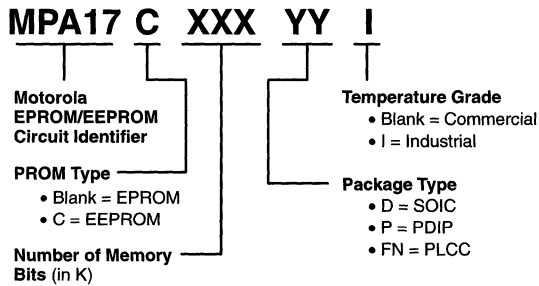


## Motorola Programmable Arrays (MPA)

### FPGA Nomenclature



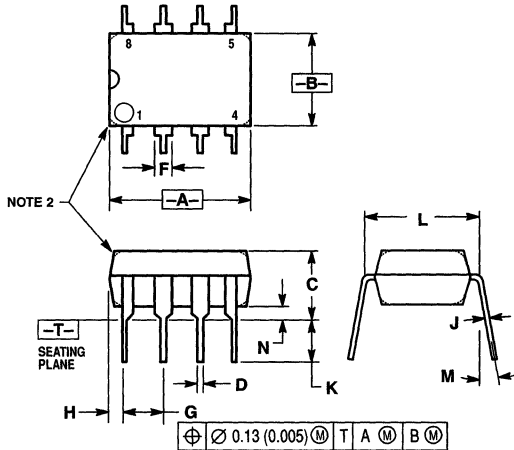
### EPROM Nomenclature



# Case Outlines

## 8-Pin Packages

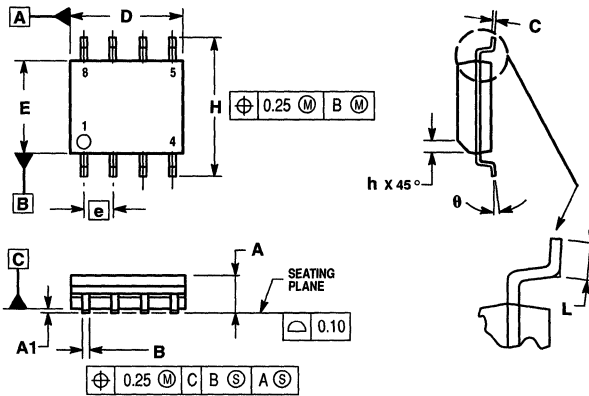
### P SUFFIX PLASTIC DIP PACKAGE CASE 626-05 ISSUE K



- NOTES:
1. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.
  2. PACKAGE CONTOUR OPTIONAL (ROUND OR SQUARE CORNERS).
  3. DIMENSIONING AND TOLERANCING PER ANS Y14.5M, 1982.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	9.40	10.16	0.370	0.400
B	6.10	6.60	0.240	0.260
C	3.94	4.45	0.155	0.175
D	0.38	0.51	0.015	0.020
F	1.02	1.78	0.040	0.070
G	2.54 BSC		0.100 BSC	
H	0.76	1.27	0.030	0.050
J	0.20	0.30	0.008	0.012
K	2.92	3.43	0.115	0.135
L	7.62 BSC		0.300 BSC	
M	— 10°		— 10°	
N	0.76	1.01	0.030	0.040

### D SUFFIX PLASTIC SOIC PACKAGE CASE 751-05 ISSUE R

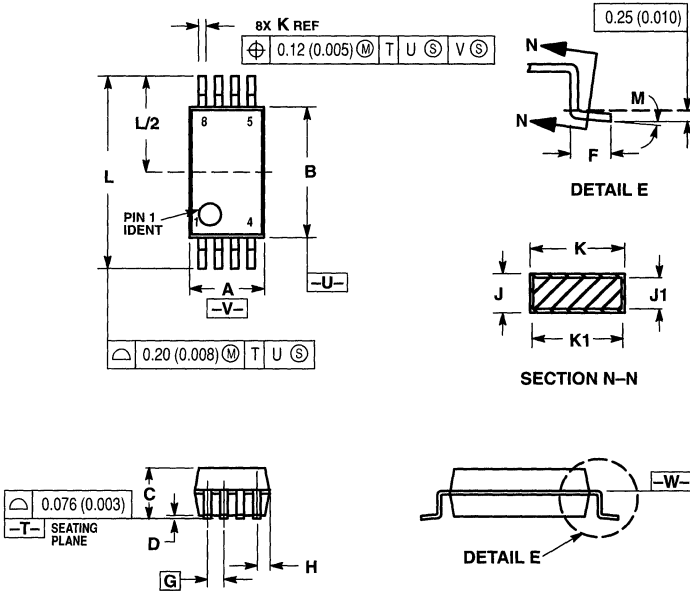


- NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
  2. DIMENSIONS ARE IN MILLIMETERS.
  3. DIMENSION D AND E DO NOT INCLUDE MOLD PROTRUSION.
  4. MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.
  5. DIMENSION B DOES NOT INCLUDE MOLD PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 TOTAL IN EXCESS OF THE B DIMENSION AT MAXIMUM MATERIAL CONDITION.

DIM	MILLIMETERS	
	MIN	MAX
A	1.35	1.75
A1	0.10	0.25
B	0.35	0.49
C	0.18	0.25
D	4.80	5.00
E	3.80	4.00
e	1.27 BSC	
H	5.80	6.20
h	0.25	0.50
L	0.40	1.25
$\theta$	0° 7°	

## 8-Pin Packages

### SD SUFFIX PLASTIC SSOP PACKAGE CASE 940-03 ISSUE B



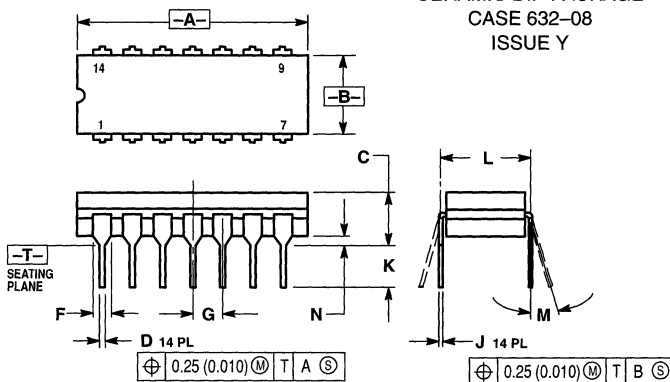
#### NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
5. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION/INTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.13 (0.005) TOTAL IN EXCESS OF K DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR INTRUSION SHALL NOT REDUCE DIMENSION K BY MORE THAN 0.07 (0.002) AT LEAST MATERIAL CONDITION.
6. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
7. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	2.87	3.13	0.113	0.123
B	5.20	5.38	0.205	0.212
C	1.73	1.99	0.068	0.078
D	0.05	0.21	0.002	0.008
F	0.63	0.95	0.024	0.037
G	0.65 BSC		0.026 BSC	
H	0.44	0.60	0.017	0.023
J	0.09	0.20	0.003	0.008
J1	0.09	0.16	0.003	0.006
K	0.25	0.38	0.010	0.015
K1	0.25	0.33	0.010	0.013
L	7.65	7.90	0.301	0.311
M	0°	8°	0°	8°

## 14-Pin Packages

### L, J SUFFIX CERAMIC DIP PACKAGE CASE 632-08 ISSUE Y



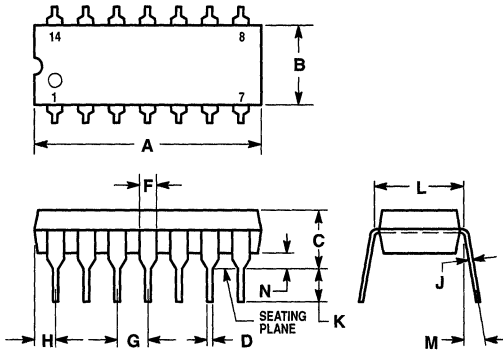
#### NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.
4. DIMENSION F MAY NARROW TO 0.76 (0.030) WHERE THE LEAD ENTERS THE CERAMIC BODY.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.750	0.785	19.05	19.94
B	0.245	0.280	6.23	7.11
C	0.155	0.200	3.94	5.08
D	0.015	0.020	0.39	0.50
F	0.055	0.065	1.40	1.65
G	0.100 BSC		2.54 BSC	
J	0.008	0.015	0.21	0.38
K	0.125	0.170	3.18	4.31
L	0.300 BSC		7.62 BSC	
M	0°	15°	0°	15°
N	0.020	0.040	0.51	1.01

# 14-Pin Packages

## P,N SUFFIX PLASTIC DIP PACKAGE CASE 646-06 ISSUE L

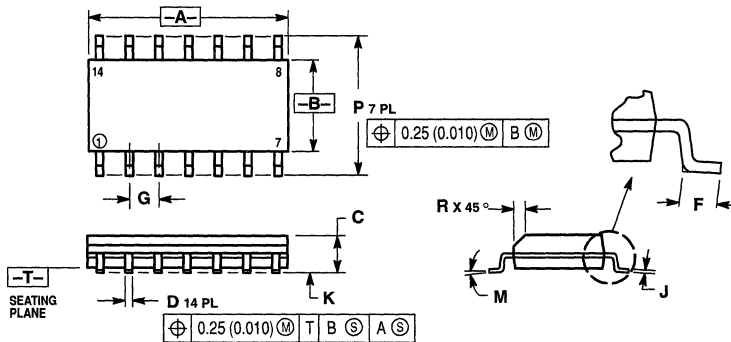


**NOTES:**

- LEADS WITHIN 0.13 (0.005) RADIUS OF TRUE POSITION AT SEATING PLANE AT MAXIMUM MATERIAL CONDITION.
- DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
- DIMENSION B DOES NOT INCLUDE MOLD FLASH.
- ROUNDED CORNERS OPTIONAL.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.715	0.770	18.16	19.56
B	0.240	0.260	6.10	6.60
C	0.145	0.185	3.69	4.69
D	0.015	0.021	0.38	0.53
F	0.040	0.070	1.02	1.78
G	0.100 BSC		2.54 BSC	
H	0.052	0.095	1.32	2.41
J	0.008	0.015	0.20	0.38
K	0.115	0.135	2.92	3.43
L	0.300 BSC		7.62 BSC	
M	0°	10°	0°	10°
N	0.015	0.039	0.39	1.01

## D SUFFIX PLASTIC SOIC PACKAGE CASE 751A-03 ISSUE F



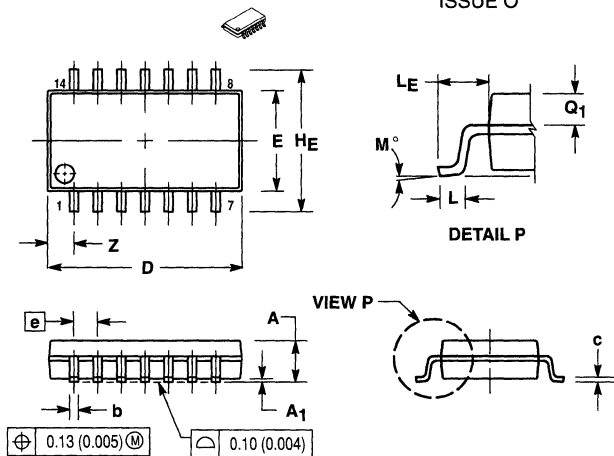
**NOTES:**

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: MILLIMETER.
- DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
- MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
- DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	8.55	8.75	0.337	0.344
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.054	0.068
D	0.35	0.49	0.014	0.019
F	0.40	1.25	0.016	0.049
G	1.27 BSC		0.050 BSC	
J	0.19	0.25	0.008	0.009
K	0.10	0.25	0.004	0.009
M	0°	7°	0°	7°
P	5.80	6.20	0.228	0.244
R	0.25	0.50	0.010	0.019

## 14-Pin Packages

### M SUFFIX PLASTIC SOIC EIAJ PACKAGE CASE 965-01 ISSUE O

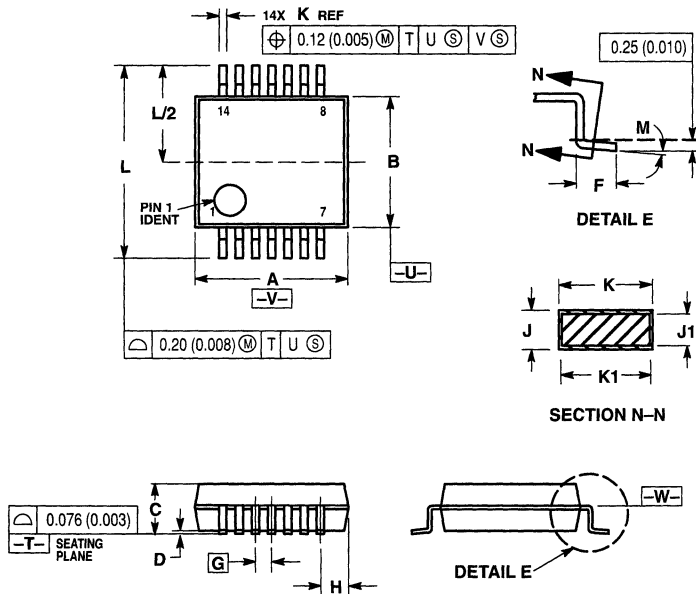


#### NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: MILLIMETER.
- DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS AND ARE MEASURED AT THE PARTING LINE. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
- TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
- THE LEAD WIDTH DIMENSION (b) DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE LEAD WIDTH DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT. MINIMUM SPACE BETWEEN PROTRUSIONS AND ADJACENT LEAD TO BE 0.46 (0.018).

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	—	2.65	—	0.081
A1	0.05	0.20	0.002	0.008
b	0.35	0.50	0.014	0.020
c	0.18	0.27	0.007	0.011
D	9.90	10.50	0.390	0.413
E	5.10	5.45	0.201	0.215
e	1.27 BSC	—	0.050 BSC	—
HE	7.40	8.20	0.291	0.323
0.50	0.50	0.85	0.020	0.033
L	1.10	1.50	0.043	0.059
M	0°	10°	0°	10°
Q1	0.70	0.90	0.028	0.035
Z	—	1.42	—	0.056

### SD SUFFIX PLASTIC SSOP PACKAGE CASE 940A-03 ISSUE B



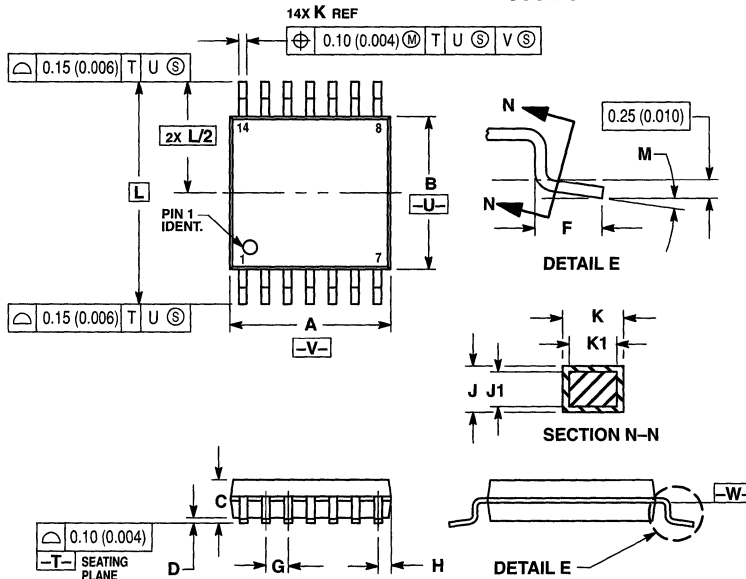
#### NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: MILLIMETER.
- DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
- DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
- DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION/INTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.13 (0.005) TOTAL IN EXCESS OF K DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR INTRUSION SHALL NOT REDUCE DIMENSION K BY MORE THAN 0.07 (0.002) AT LEAST MATERIAL CONDITION.
- TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
- DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	6.07	6.33	0.238	0.249
B	5.20	5.38	0.205	0.212
C	1.73	1.99	0.068	0.078
D	0.05	0.21	0.002	0.008
F	0.63	0.95	0.024	0.037
G	0.65 BSC	—	0.026 BSC	—
H	1.08	1.22	0.042	0.048
J	0.09	0.20	0.003	0.008
J1	0.09	0.16	0.003	0.006
K	0.25	0.38	0.010	0.015
K1	0.25	0.33	0.010	0.013
L	7.65	7.90	0.301	0.311
M	0°	8°	0°	8°

## 14-Pin Packages

### DT SUFFIX PLASTIC TSSOP PACKAGE CASE 948G-01 ISSUE O

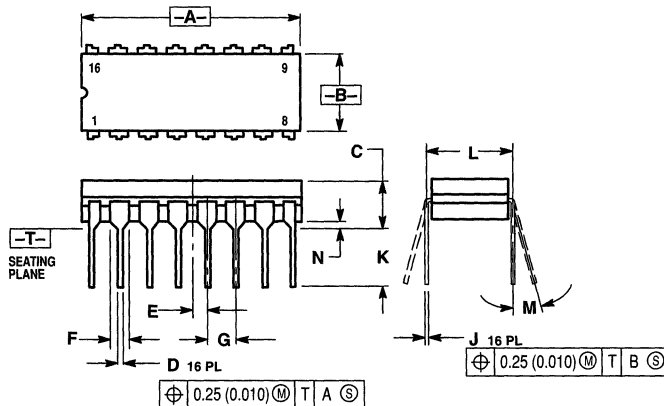


- NOTES:
- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  - CONTROLLING DIMENSION: MILLIMETER.
  - DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
  - DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
  - DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
  - TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
  - DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.90	5.10	0.193	0.200
B	4.30	4.50	0.169	0.177
C	—	1.20	—	0.047
D	0.05	0.15	0.002	0.006
F	0.50	0.75	0.020	0.030
G	0.65 BSC			
H	0.50	0.60	0.020	0.024
J	0.09	0.20	0.004	0.008
J1	0.08	0.16	0.004	0.006
K	0.19	0.30	0.007	0.012
K1	0.19	0.25	0.007	0.010
L	8.40 BSC			
M	0°		8°	
	0°		8°	

## 16-Pin Packages

### L, J SUFFIX CERAMIC DIP PACKAGE CASE 620-10 ISSUE V

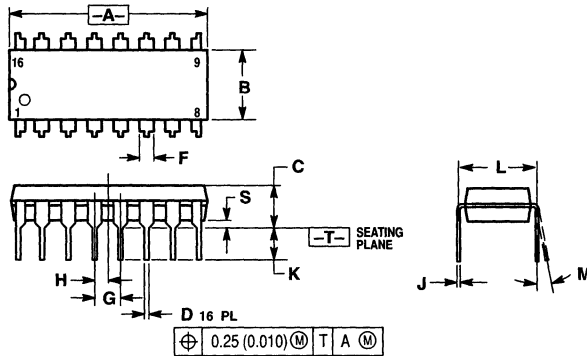


- NOTES:
- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  - CONTROLLING DIMENSION: INCH.
  - DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.
  - DIMENSION F MAY NARROW TO 0.76 (0.030) WHERE THE LEAD ENTERS THE CERAMIC BODY.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.750	0.785	19.05	19.93
B	0.240	0.295	6.10	7.49
C	0.200			
D	0.015	0.020	0.39	0.50
E	0.050 BSC			
F	0.055   0.065			
G	0.100 BSC			
H	0.008	0.015	0.21	0.38
K	0.125	0.170	3.18	4.31
L	0.300 BSC			
M	0°		15°	
N	0.020	0.040	0.51	1.01

## 16-Pin Packages

### P,N SUFFIX PLASTIC DIP PACKAGE CASE 648-08 ISSUE R

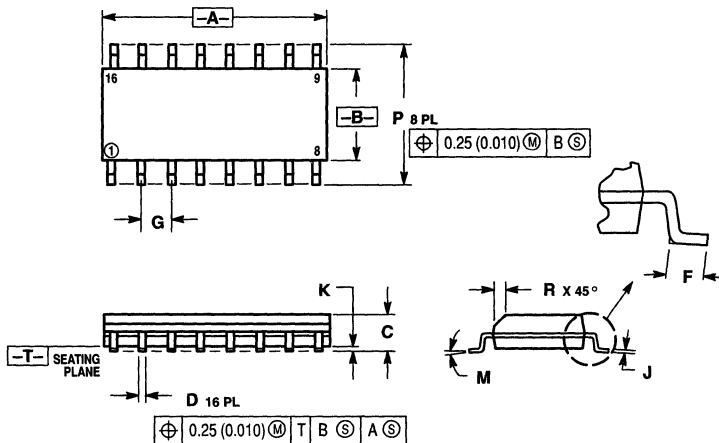


#### NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
5. ROUNDED CORNERS OPTIONAL.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.740	0.770	18.80	19.55
B	0.250	0.270	6.35	6.85
C	0.145	0.175	3.69	4.44
D	0.015	0.021	0.39	0.53
F	0.040	0.70	1.02	1.77
G	0.100 BSC		2.54 BSC	
H	0.050 BSC		1.27 BSC	
J	0.008	0.015	0.21	0.38
K	0.110	0.130	2.80	3.30
L	0.295	0.305	7.50	7.74
M	0° - 10°		0° - 10°	
S	0.020	0.040	0.51	1.01

### D SUFFIX PLASTIC SOIC PACKAGE CASE 751B-05 ISSUE J



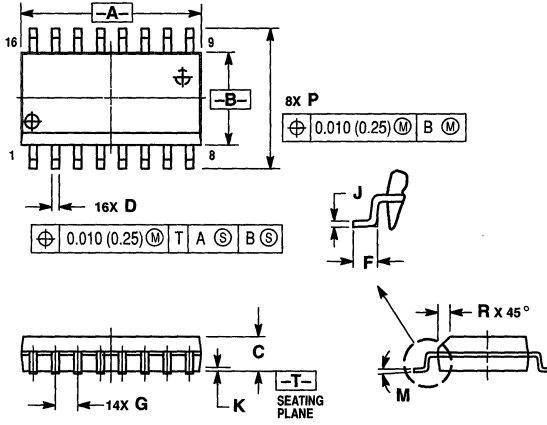
#### NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	9.80	10.00	0.386	0.393
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.054	0.068
D	0.35	0.49	0.014	0.019
F	0.40	1.25	0.016	0.049
G	1.27 BSC		0.050 BSC	
J	0.19	0.25	0.008	0.009
K	0.10	0.25	0.004	0.009
M	0° - 7°		0° - 7°	
P	5.80	6.20	0.229	0.244
R	0.25	0.50	0.010	0.019

# 16-Pin Packages

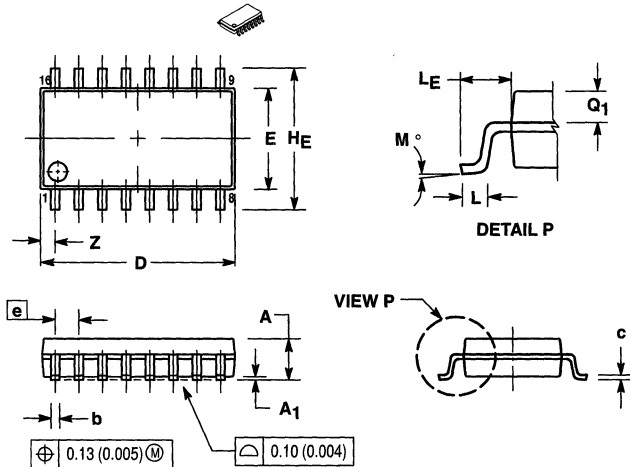
## DW SUFFIX PLASTIC WIDE SOIC PACKAGE CASE 751G-02 ISSUE A



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: MILLIMETER.
  3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
  4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
  5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.13 (0.005) TOTAL IN EXCESS OF D DIMENSION AT MAXIMUM MATERIAL CONDITION.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	10.15	10.45	0.400	0.411
B	7.40	7.60	0.292	0.299
C	2.35	2.65	0.093	0.104
D	0.35	0.49	0.014	0.019
F	0.50	0.90	0.020	0.035
G	1.27 BSC		0.050 BSC	
J	0.25	0.32	0.010	0.012
K	0.10	0.25	0.004	0.009
M	0°	7°	0°	7°
P	10.05	10.55	0.395	0.415
R	0.25	0.75	0.010	0.029

## M SUFFIX PLASTIC SOIC EIAJ PACKAGE CASE 966-01 ISSUE O



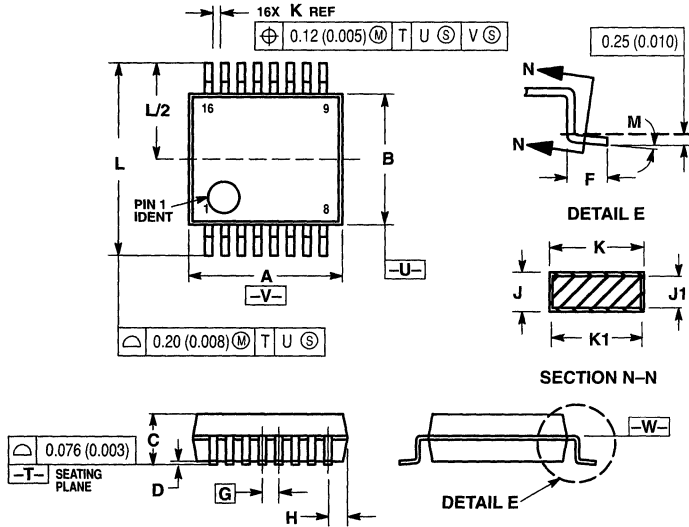
- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: MILLIMETER.
  3. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS AND ARE MEASURED AT THE PARTING LINE. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
  4. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
  5. THE LEAD WIDTH DIMENSION (b) DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE LEAD WIDTH DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT. MINIMUM SPACE BETWEEN PROTRUSIONS AND ADJACENT LEAD TO BE 0.46 (0.018).

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	—	2.05	—	0.081
A <sub>1</sub>	0.05	0.20	0.002	0.008
b	0.35	0.50	0.014	0.020
c	0.18	0.27	0.007	0.011
D	9.90	10.50	0.390	0.413
E	5.10	5.45	0.201	0.215
e	1.27 BSC		0.050 BSC	
H <sub>E</sub>	7.40	8.20	0.291	0.323
L	0.50	0.85	0.020	0.033
L <sub>F</sub>	1.10	1.50	0.043	0.059
M	0°	10°	0°	10°
Q <sub>1</sub>	0.70	0.90	0.028	0.035
Z	—	0.78	—	0.031



# 16-Pin Packages

## SD SUFFIX PLASTIC SSOP PACKAGE CASE 940B-03 ISSUE B

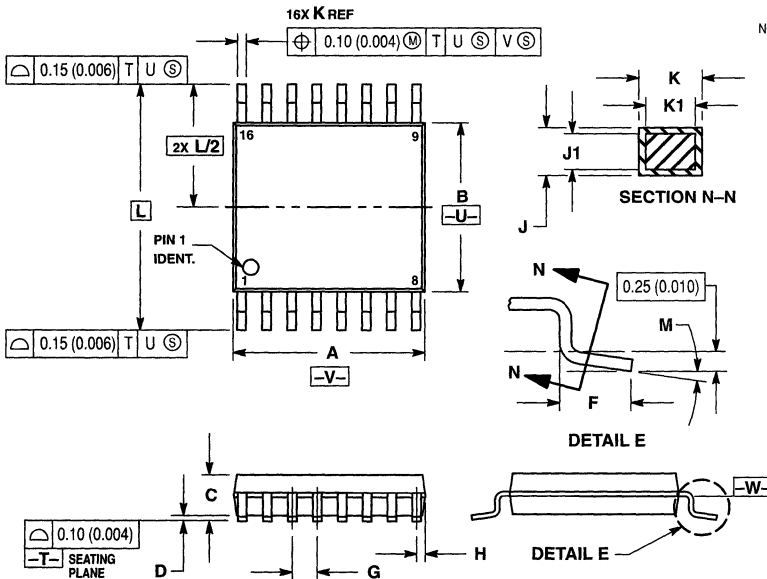


**NOTES:**

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982
2. CONTROLLING DIMENSION: MILLIMETER
3. DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
5. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION/INTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.13 (0.005) TOTAL IN EXCESS OF K DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR INTRUSION SHALL NOT REDUCE DIMENSION K BY MORE THAN 0.07 (0.002) AT LEAST MATERIAL CONDITION.
6. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
7. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	6.07	6.33	0.238	0.249
B	5.20	5.38	0.205	0.212
C	1.73	1.99	0.068	0.078
D	0.05	0.21	0.002	0.008
F	0.63	0.95	0.024	0.037
G	0.65 BSC		0.026 BSC	
H	0.73	0.90	0.028	0.035
J	0.09	0.20	0.003	0.008
J1	0.09	0.16	0.003	0.006
K	0.25	0.38	0.010	0.015
K1	0.25	0.33	0.010	0.013
L	7.65	7.90	0.301	0.311
M	0°	8°	0°	8°

## DT SUFFIX PLASTIC TSSOP PACKAGE CASE 948F-01 ISSUE O



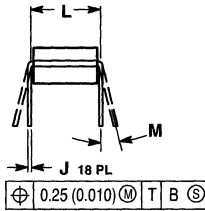
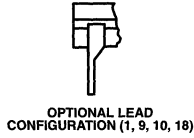
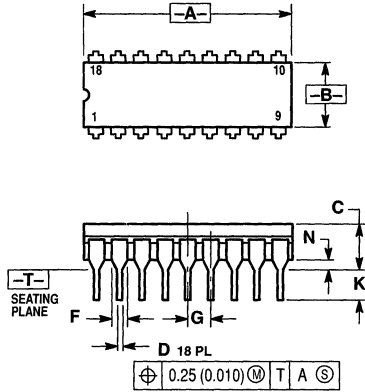
**NOTES:**

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER
3. DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
5. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
6. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
7. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.90	5.10	0.193	0.200
B	4.30	4.50	0.169	0.177
C	—	1.20	—	0.047
D	0.05	0.15	0.002	0.006
F	0.50	0.75	0.020	0.030
G	0.65 BSC		0.026 BSC	
H	0.18	0.28	0.007	0.011
J	0.09	0.20	0.004	0.008
J1	0.09	0.16	0.004	0.006
K	0.19	0.30	0.007	0.012
K1	0.19	0.25	0.007	0.010
L	6.40 BSC		0.252 BSC	
M	0°	8°	0°	8°

# 18-Pin Packages

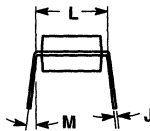
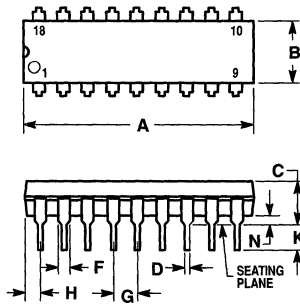
## L, J SUFFIX CERAMIC DIP PACKAGE CASE 726-04 ISSUE G



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: INCH.
  3. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.
  4. DIMENSION F FOR FULL LEADS. HALF LEADS OPTIONAL AT LEAD POSITIONS 1, 9, 10, AND 18.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.890	0.910	22.35	23.11
B	0.240	0.295	6.10	7.49
C	—	0.200	—	5.08
D	0.015	0.021	0.38	0.53
F	0.055	0.070	1.40	1.78
G	0.100 BSC		2.54 BSC	
J	0.008	0.012	0.20	0.30
K	0.125	0.170	3.18	4.32
L	0.300 BSC		7.62 BSC	
M	0° - 15°		0° - 15°	
N	0.020	0.040	0.51	1.02

## P, N SUFFIX PLASTIC DIP PACKAGE CASE 707-02 ISSUE C

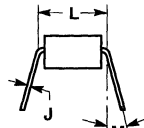
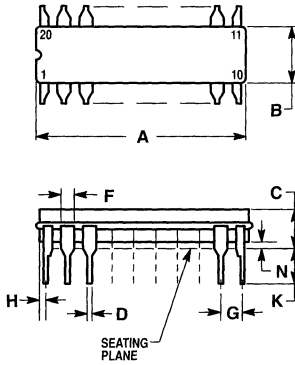


- NOTES:
1. POSITIONAL TOLERANCE OF LEADS (D), SHALL BE WITHIN 0.25 (0.010) AT MAXIMUM MATERIAL CONDITION, IN RELATION TO SEATING PLANE AND EACH OTHER.
  2. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
  3. DIMENSION B DOES NOT INCLUDE MOLD FLASH.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	22.22	23.24	0.875	0.915
B	6.10	6.60	0.240	0.260
C	3.55	4.57	0.140	0.180
D	0.36	0.56	0.014	0.022
F	1.27	1.78	0.050	0.070
G	2.54 BSC		0.100 BSC	
H	1.02	1.52	0.040	0.060
J	0.20	0.30	0.008	0.012
K	2.92	3.43	0.115	0.135
L	7.62 BSC		0.300 BSC	
M	0° - 15°		0° - 15°	
N	0.51	1.02	0.020	0.040

## 20-Pin Packages

### L, J SUFFIX CERAMIC DIP PACKAGE CASE 732-03 ISSUE E

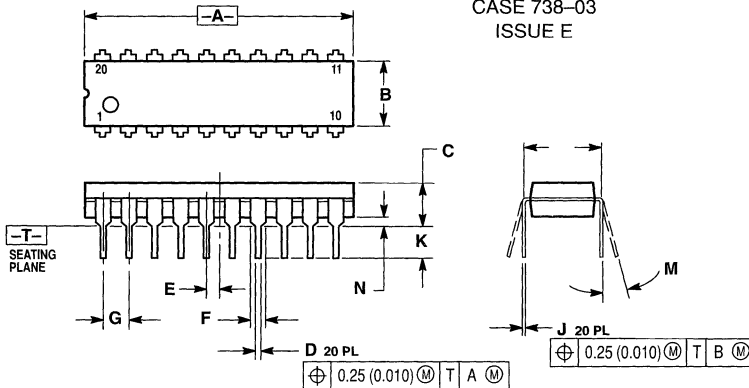


NOTES:

- LEADS WITHIN 0.25 (0.010) DIAMETER, TRUE POSITION AT SEATING PLANE, AT MAXIMUM MATERIAL CONDITION.
- DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
- DIMENSIONS A AND B INCLUDE MENISCUS.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	23.88	25.15	0.940	0.990
B	6.60	7.49	0.260	0.295
C	3.81	5.08	0.150	0.200
D	0.38	0.56	0.015	0.022
F	1.40	1.65	0.055	0.065
G	2.54 BSC			
H	0.51	1.27	0.020	0.050
J	0.20	0.30	0.008	0.012
K	3.18	4.06	0.125	0.160
L	7.62 BSC			
M	0°	15°	0°	15°
N	0.25	1.02	0.010	0.040

### P, N SUFFIX PLASTIC DIP PACKAGE CASE 738-03 ISSUE E

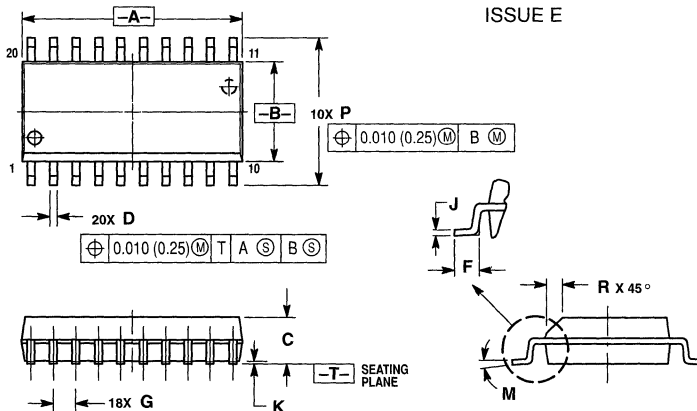


NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: INCH.
- DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.
- DIMENSION B DOES NOT INCLUDE MOLD FLASH.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	1.310	1.070	25.66	27.17
B	0.240	0.260	6.10	6.60
C	0.150	0.180	3.81	4.57
D	0.015	0.022	0.39	0.55
E	0.050 BSC			
F	0.050	0.070	1.27	1.77
G	0.100 BSC			
J	0.008	0.015	0.21	0.38
K	0.110	0.140	2.80	3.55
L	0.300 BSC			
M	0°	15°	0°	15°
N	0.020	0.040	0.51	1.01

### DW SUFFIX PLASTIC WIDE SOIC PACKAGE CASE 751D-04 ISSUE E

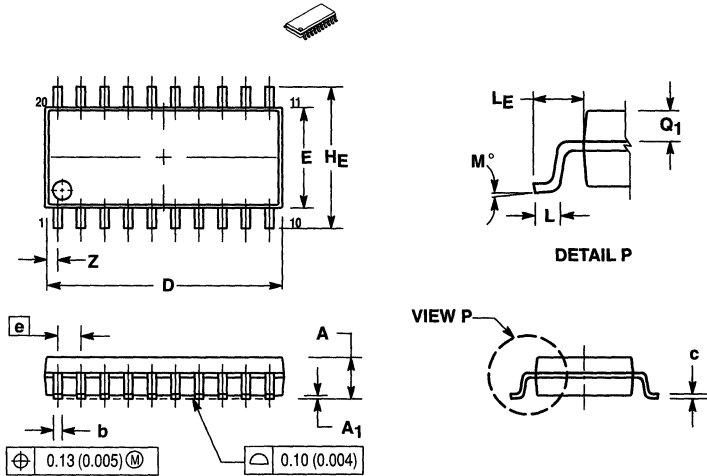


NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: MILLIMETER.
- DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
- MAXIMUM MOLD PROTRUSION 0.150 (0.006) PER SIDE.
- DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION ALLOWABLE. DAMBAR PROTRUSION SHALL BE 0.13 (0.005) TOTAL IN EXCESS OF D DIMENSION AT MAXIMUM MATERIAL CONDITION.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	12.65	12.95	0.499	0.510
B	7.40	7.60	0.292	0.299
C	2.35	2.65	0.093	0.104
D	0.35	0.49	0.014	0.019
F	0.50	0.90	0.020	0.035
G	1.27 BSC			
J	0.25	0.32	0.010	0.012
K	0.10	0.25	0.004	0.009
M	0°	7°	0°	7°
P	10.05	10.55	0.395	0.415
R	0.25	0.75	0.010	0.029

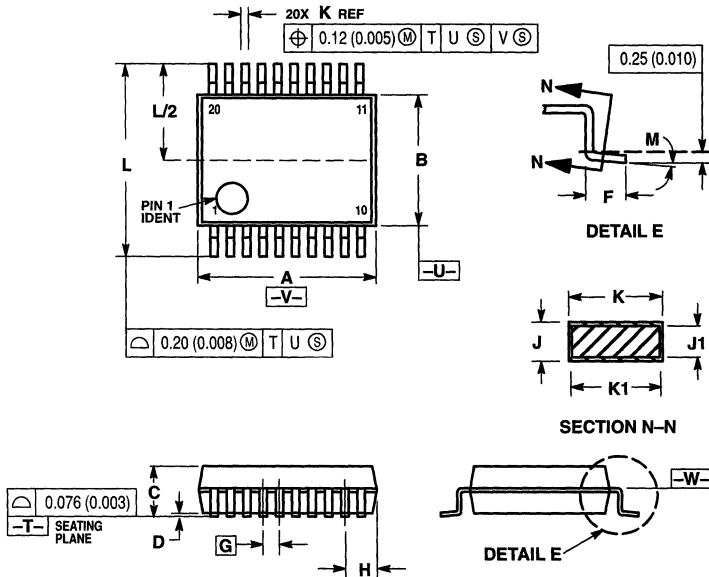
**M SUFFIX**  
**PLASTIC SOIC EIAJ PACKAGE**  
 CASE 967-01  
 ISSUE O



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: MILLIMETER.
  3. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS AND ARE MEASURED AT THE PARTING LINE. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
  4. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
  5. THE LEAD WIDTH DIMENSION (b) DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE LEAD WIDTH DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT. MINIMUM SPACE BETWEEN PROTRUSIONS AND ADJACENT LEAD TO BE 0.46 (0.018).

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	—	2.05	—	0.081
A1	0.05	0.20	0.002	0.008
b	0.35	0.50	0.014	0.020
c	0.18	0.27	0.007	0.011
D	12.35	12.80	0.486	0.504
E	5.10	5.45	0.201	0.215
e	1.27 BSC 0.050 BSC			
HE	7.40	8.20	0.291	0.323
L	0.50	0.85	0.020	0.033
LE	1.10	1.50	0.043	0.059
M	0°	10°	0°	10°
Q1	0.70	0.90	0.028	0.035
Z	—	0.81	—	0.032

**SD SUFFIX**  
**PLASTIC SSOP PACKAGE**  
 CASE 940C-03  
 ISSUE B

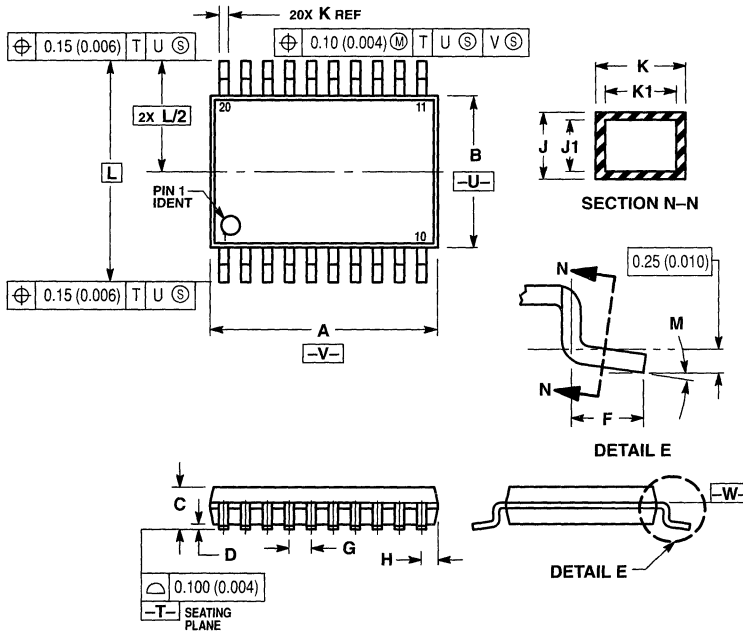


- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: MILLIMETER.
  3. DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
  4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
  5. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION/INTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.13 (0.005) TOTAL IN EXCESS OF K DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR INTRUSION SHALL NOT REDUCE DIMENSION K BY MORE THAN 0.07 (0.002) AT LEAST MATERIAL CONDITION.
  6. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
  7. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	7.07	7.33	0.278	0.288
B	5.20	5.38	0.205	0.212
C	1.73	1.99	0.068	0.078
D	0.05	0.21	0.002	0.008
F	0.63	0.95	0.024	0.037
G	0.65 BSC 0.026 BSC			
H	0.59	0.75	0.023	0.030
J	0.09	0.20	0.003	0.008
J1	0.09	0.16	0.003	0.006
K	0.25	0.38	0.010	0.015
K1	0.25	0.33	0.010	0.013
L	7.65	7.90	0.301	0.311
M	0°	8°	0°	8°

20-Pin Packages

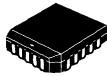
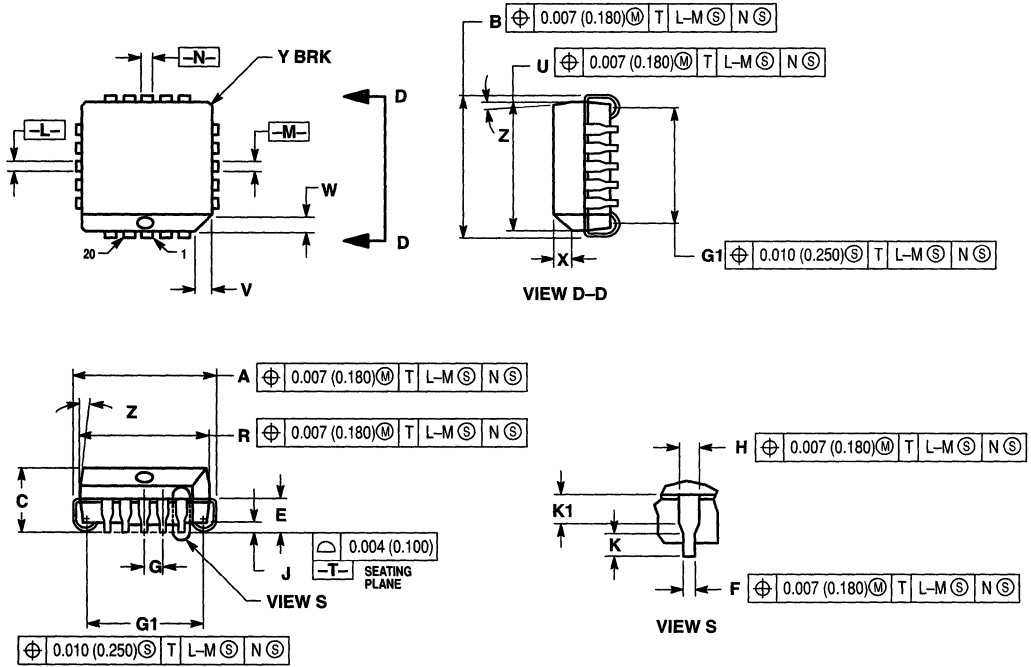
DT SUFFIX  
 PLASTIC TSSOP PACKAGE  
 CASE 948E-02  
 ISSUE A



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: MILLIMETER.
  3. DIMENSION A DOES NOT INCLUDE MOLD FLASH; PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
  4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
  5. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
  6. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
  7. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	6.40	6.60	0.252	0.260
B	4.30	4.50	0.169	0.177
C	—	1.20	—	0.047
D	0.05	0.15	0.002	0.006
F	0.50	0.75	0.020	0.030
G	0.65 BSC		0.026 BSC	
H	0.27	0.37	0.011	0.015
J	0.09	0.20	0.004	0.008
J1	0.09	0.16	0.004	0.006
K	0.19	0.30	0.007	0.012
K1	0.19	0.25	0.007	0.010
L	6.40 BSC		0.252 BSC	
M	0°	8°	0°	8°

**FN SUFFIX**  
**PLASTIC PLCC PACKAGE**  
 CASE 775-02  
 ISSUE C



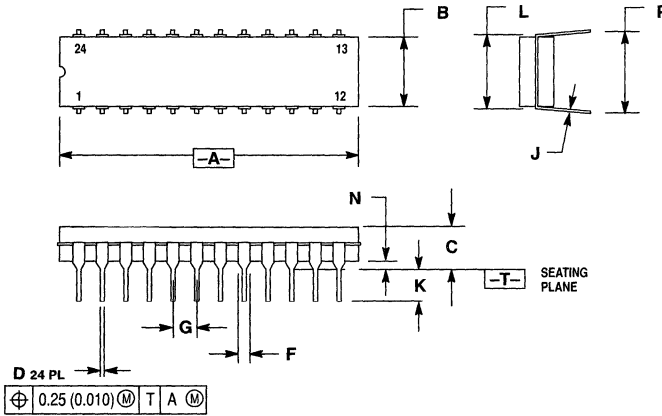
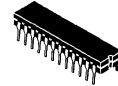
**NOTES:**

- DATUMS -L-, -M-, AND -N- DETERMINED WHERE TOP OF LEAD SHOULDER EXITS PLASTIC BODY AT MOLD PARTING LINE.
- DIMENSION G1, TRUE POSITION TO BE MEASURED AT DATUM -T-, SEATING PLANE.
- DIMENSIONS R AND U DO NOT INCLUDE MOLD FLASH. ALLOWABLE MOLD FLASH IS 0.010 (0.250) PER SIDE.
- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: INCH.
- THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM BY UP TO 0.012 (0.300). DIMENSIONS R AND U ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.
- DIMENSION H DOES NOT INCLUDE DAMBAR PROTRUSION(S) OR INTRUSION. THE DAMBAR PROTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE GREATER THAN 0.037 (0.940). THE DAMBAR INTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE SMALLER THAN 0.025 (0.635).

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.365	0.395	9.76	10.03
B	0.365	0.395	9.76	10.03
C	0.165	0.180	4.20	4.57
E	0.090	0.110	2.29	2.79
F	0.013	0.019	0.33	0.48
G	0.050 BSC		1.27 BSC	
H	0.026	0.032	0.66	0.81
J	0.020	—	0.51	—
K	0.025	—	0.64	—
R	0.350	0.356	8.89	9.04
U	0.350	0.356	8.89	9.04
V	0.042	0.048	1.07	1.21
W	0.042	0.048	1.07	1.21
X	0.042	0.056	1.07	1.42
Y	—	0.020	—	0.50
Z	2°	10°	2°	10°
G1	0.310	0.330	7.88	8.38
K1	0.040	—	1.02	—

## 24-Pin Packages

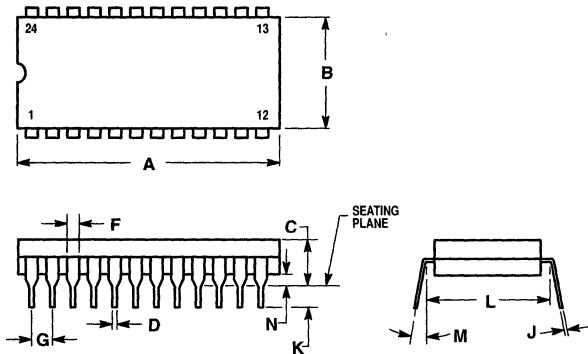
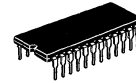
### J SUFFIX CERAMIC DIP PACKAGE CASE 758-02 ISSUE A



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982
  2. CONTROLLING DIMENSION: INCH.
  3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	1.240	1.285	31.50	32.64
B	0.285	0.305	7.24	7.75
C	0.160	0.200	4.07	5.08
D	0.015	0.021	0.38	0.53
F	0.045	0.062	1.14	1.57
G	0.100 BSC		2.54 BSC	
J	0.008	0.013	0.20	0.33
K	0.100	0.165	2.54	4.19
L	0.300	0.310	7.62	7.87
N	0.020	0.050	0.51	1.27
P	0.360	0.400	9.14	10.16

### L, J, JW SUFFIX CERAMIC DIP PACKAGE CASE 623-05 ISSUE M

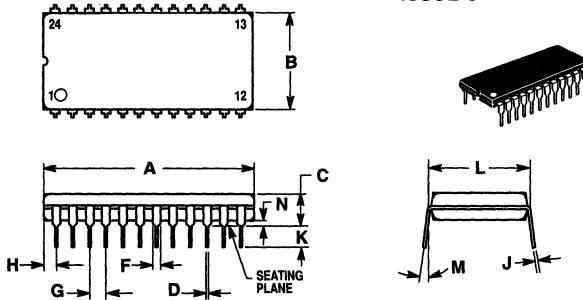


- NOTES:
1. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
  2. LEADS WITHIN  $0.13 (0.005)$  RADIUS OF TRUE POSITION AT SEATING PLANE AT MAXIMUM MATERIAL CONDITION (WHEN FORMED PARALLEL).

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	31.24	32.77	1.230	1.290
B	12.70	15.49	0.500	0.610
C	4.06	5.59	0.160	0.220
D	0.41	0.51	0.016	0.020
F	1.27	1.52	0.050	0.060
G	2.54 BSC		0.100 BSC	
J	0.20	0.30	0.008	0.012
K	3.18	4.06	0.125	0.160
L	15.24 BSC		0.600 BSC	
M	0° - 15°		0° - 15°	
N	0.51	1.27	0.020	0.050

## 24-Pin Packages

### N SUFFIX PLASTIC DIP PACKAGE CASE 709-02 ISSUE C

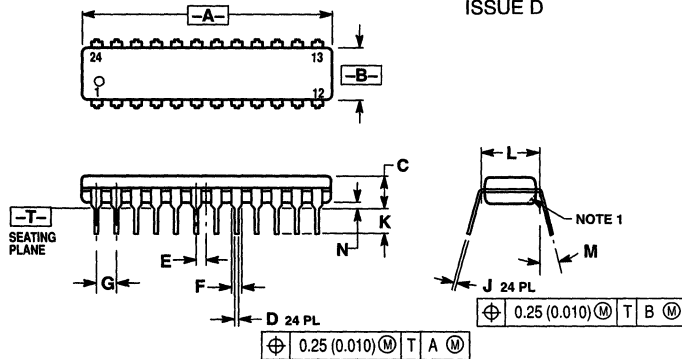


NOTES:

1. POSITIONAL TOLERANCE OF LEADS (D), SHALL BE WITHIN 0.25 (0.010) AT MAXIMUM MATERIAL CONDITION, IN RELATION TO SEATING PLANE AND EACH OTHER.
2. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
3. DIMENSION B DOES NOT INCLUDE MOLD FLASH.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	31.37	32.13	1.235	1.265
B	13.72	14.22	0.540	0.560
C	3.94	5.08	0.155	0.200
D	0.36	0.56	0.014	0.022
F	1.02	1.52	0.040	0.060
G	2.54 BSC			
H	1.65	2.03	0.065	0.080
J	0.20	0.38	0.008	0.015
K	2.92	3.43	0.115	0.135
L	15.24 BSC			
M	0° 15°			
N	0.51 1.02 0.020 0.040			

### P,N SUFFIX PLASTIC DIP PACKAGE CASE 724-03 ISSUE D

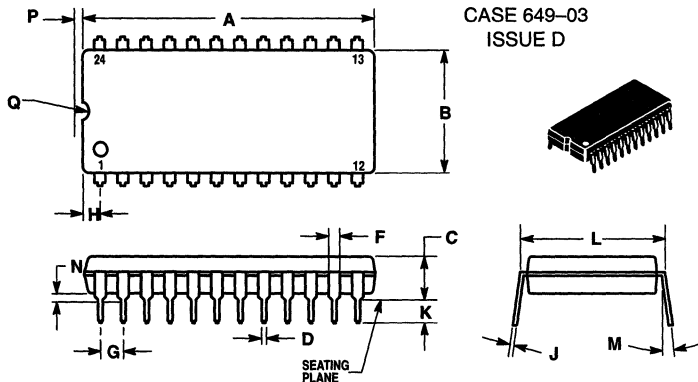


NOTES:

1. CHAMFERED CONTOUR OPTIONAL.
2. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
3. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
4. CONTROLLING DIMENSION: INCH.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	1.230	1.265	31.25	32.13
B	0.250	0.270	6.35	6.85
C	0.145	0.175	3.69	4.44
D	0.015	0.020	0.38	0.51
E	0.050 BSC			
F	0.040	0.060	1.02	1.52
G	0.100 BSC			
J	0.007	0.012	0.18	0.30
K	0.110	0.140	2.80	3.55
L	0.300 BSC			
M	0° 15°			
N	0.020	0.040	0.51	1.01

### P,N,PW SUFFIX PLASTIC DIP PACKAGE CASE 649-03 ISSUE D



NOTES:

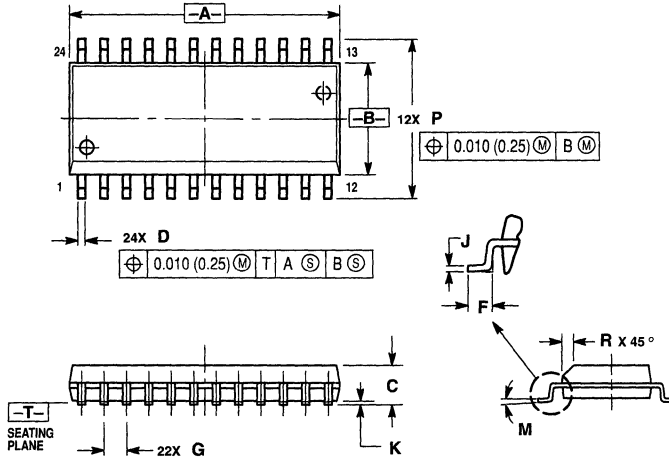
1. LEADS WITHIN 0.13 (0.005) RADIUS OF TRUE POSITION AT SEATING PLANE AT MAXIMUM MATERIAL CONDITION.
2. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	31.50	32.13	1.240	1.265
B	13.21	13.72	0.520	0.540
C	4.70	5.21	0.185	0.205
D	0.38	0.51	0.015	0.020
F	1.02	1.52	0.040	0.060
G	2.54 BSC			
H	1.65	2.16	0.065	0.085
J	0.20	0.30	0.008	0.012
K	2.92	3.43	0.115	0.135
L	14.99	15.49	0.590	0.610
M	— 10°			
N	0.51	1.02	0.020	0.040
P	0.13	0.38	0.005	0.015
Q	0.51	0.76	0.020	0.030



## 24-Pin Packages

### DW SUFFIX PLASTIC WIDE SOIC PACKAGE CASE 751E-04 ISSUE E

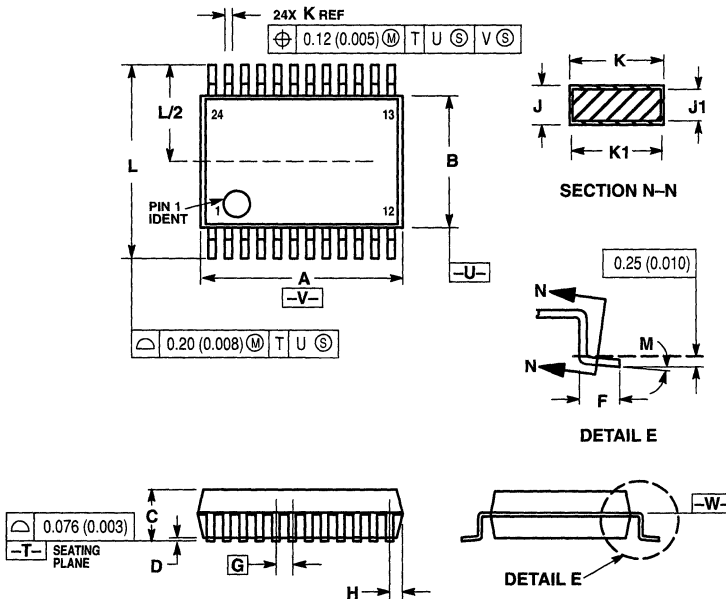


#### NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.13 (0.005) TOTAL IN EXCESS OF D DIMENSION AT MAXIMUM MATERIAL CONDITION.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	15.25	15.54	0.601	0.612
B	7.40	7.60	0.292	0.299
C	2.35	2.65	0.093	0.104
D	0.35	0.49	0.014	0.019
F	0.41	0.90	0.016	0.035
G	1.27 BSC		0.050 BSC	
J	0.23	0.32	0.009	0.013
K	0.13	0.29	0.005	0.011
M	0°	8°	0°	8°
P	10.05	10.55	0.395	0.415
R	0.25	0.75	0.010	0.029

### SD SUFFIX PLASTIC SSOP PACKAGE CASE 940D-03 ISSUE B



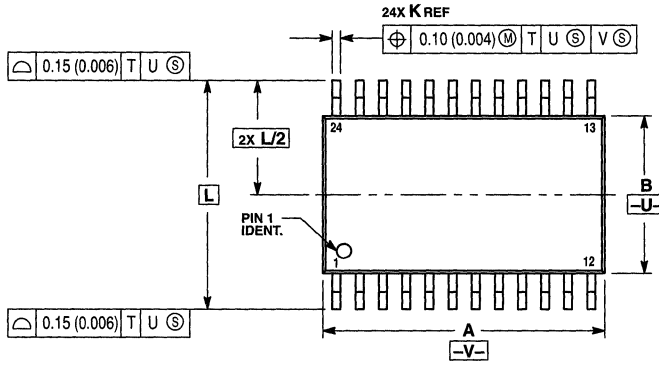
#### NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
5. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION/INTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.13 (0.005) TOTAL IN EXCESS OF K DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR INTRUSION SHALL NOT REDUCE DIMENSION K BY MORE THAN 0.07 (0.002) AT LEAST MATERIAL CONDITION.
6. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
7. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

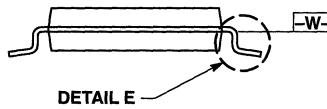
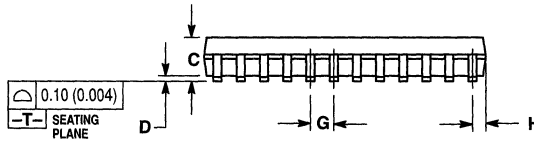
DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	8.07	8.33	0.317	0.328
B	5.20	5.38	0.205	0.212
C	1.73	1.99	0.068	0.078
D	0.05	0.21	0.002	0.008
F	0.63	0.95	0.024	0.037
G	0.65 BSC		0.026 BSC	
H	0.44	0.60	0.017	0.024
J	0.09	0.20	0.003	0.008
J1	0.09	0.16	0.003	0.006
K	0.25	0.38	0.010	0.015
K1	0.25	0.33	0.010	0.013
L	7.65	7.90	0.301	0.311
M	0°	8°	0°	8°

# 24-Pin Packages

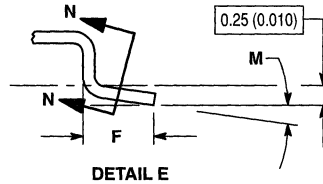
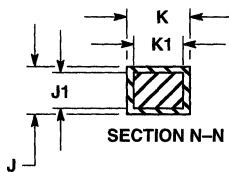
## DT SUFFIX PLASTIC TSSOP PACKAGE CASE 948H-01 ISSUE O



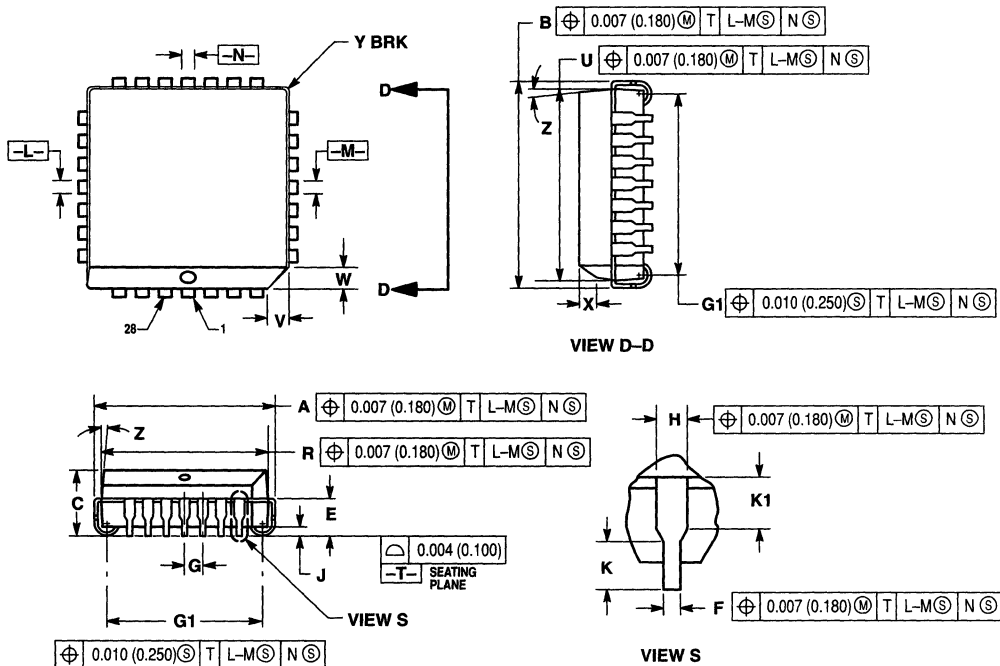
- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: MILLIMETER.
  3. DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
  4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
  5. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
  6. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
  7. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.



DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	7.70	7.90	0.303	0.311
B	4.30	4.50	0.169	0.177
C	—	1.20	—	0.047
D	0.05	0.15	0.002	0.006
F	0.50	0.75	0.020	0.030
G	0.65 BSC		0.026 BSC	
H	0.27	0.37	0.011	0.015
J	0.09	0.20	0.004	0.008
J1	0.09	0.16	0.004	0.006
K	0.19	0.30	0.007	0.012
K1	0.19	0.25	0.007	0.010
L	6.40 BSC		0.252 BSC	
M	0°	8°	0°	8°



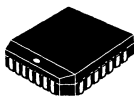
**FN SUFFIX**  
**PLASTIC PLCC PACKAGE**  
 CASE 776-02  
 ISSUE D



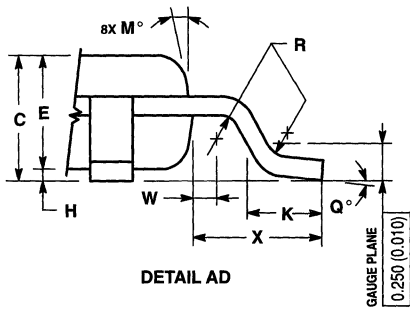
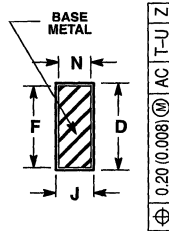
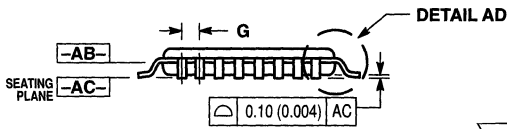
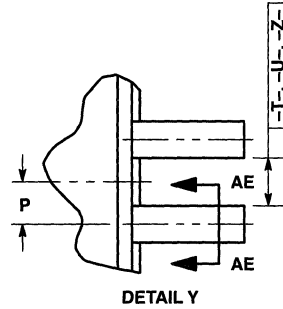
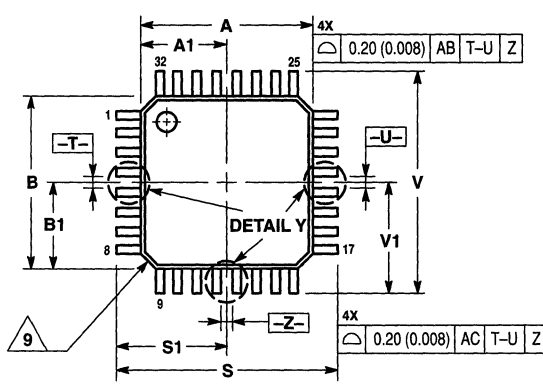
**NOTES:**

- DATUMS -L-, -M-, AND -N- DETERMINED WHERE TOP OF LEAD SHOULDER EXITS PLASTIC BODY AT MOLD PARTING LINE.
- DIMENSION G1, TRUE POSITION TO BE MEASURED AT DATUM -T-, SEATING PLANE.
- DIMENSIONS R AND U DO NOT INCLUDE MOLD FLASH. ALLOWABLE MOLD FLASH IS 0.010 (0.250) PER SIDE.
- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: INCH.
- THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM BY UP TO 0.012 (0.300). DIMENSIONS R AND U ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.
- DIMENSION H DOES NOT INCLUDE DAMBAR PROTRUSION OR INTRUSION. THE DAMBAR PROTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE GREATER THAN 0.037 (0.940). THE DAMBAR INTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE SMALLER THAN 0.025 (0.635).

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.485	0.495	12.32	12.57
B	0.485	0.495	12.32	12.57
C	0.165	0.180	4.20	4.57
E	0.090	0.110	2.29	2.79
F	0.013	0.019	0.33	0.48
G	0.050 BSC		1.27 BSC	
H	0.026	0.032	0.66	0.81
J	0.020	—	0.51	—
K	0.025	—	0.64	—
R	0.450	0.456	11.43	11.58
U	0.450	0.456	11.43	11.58
V	0.042	0.048	1.07	1.21
W	0.042	0.048	1.07	1.21
X	0.042	0.056	1.07	1.42
Y	—	0.020	—	0.50
Z	2°	10°	2°	10°
G1	0.410	0.430	10.42	10.92
K1	0.040	—	1.02	—



FA SUFFIX  
PLASTIC TQFP PACKAGE  
CASE 873A-02  
ISSUE A



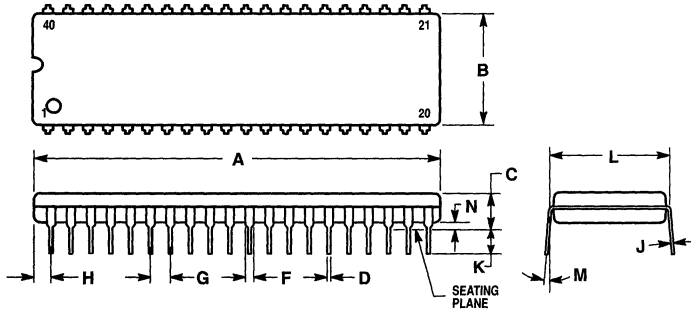
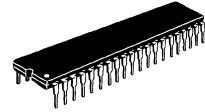
- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1992.
  2. CONTROLLING DIMENSION: MILLIMETER.
  3. DATUM PLANE -AB- IS LOCATED AT BOTTOM OF LEAD AND IS COINCIDENT WITH THE LEAD WHERE THE LEAD EXITS THE PLASTIC BODY AT THE BOTTOM OF THE PARTING LINE.
  4. DATUMS -T-, -U-, AND -Z- TO BE DETERMINED AT DATUM PLANE -AB-.
  5. DIMENSIONS S AND V TO BE DETERMINED AT SEATING PLANE -AC-.
  6. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE PROTRUSION IS 0.250 (0.010) PER SIDE. DIMENSIONS A AND B DO INCLUDE MOLD MISMATCH AND ARE DETERMINED AT DATUM PLANE -AB-.
  7. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. DAMBAR PROTRUSION SHALL NOT CAUSE THE D DIMENSION TO EXCEED 0.520 (0.020).
  8. MINIMUM SOLDER PLATE THICKNESS SHALL BE 0.0076 (0.0003).
  9. EXACT SHAPE OF EACH CORNER MAY VARY FROM DEPICTION.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	7.000 BSC		0.276 BSC	
A1	3.500 BSC		0.138 BSC	
B	7.000 BSC		0.276 BSC	
B1	3.500 BSC		0.138 BSC	
C	1.400	1.600	0.055	0.063
D	0.300	0.450	0.012	0.018
E	1.350	1.450	0.053	0.057
F	0.300	0.400	0.012	0.016
G	0.800 BSC		0.031 BSC	
H	0.050	0.150	0.002	0.006
J	0.090	0.200	0.004	0.008
K	0.500	0.700	0.020	0.028
M	12° REF		12° REF	
N	0.090	0.160	0.004	0.006
P	0.400 BSC		0.016 BSC	
Q	1°	5°	1°	5°
R	0.150	0.250	0.006	0.010
S	9.000 BSC		0.354 BSC	
S1	4.500 BSC		0.177 BSC	
V	9.000 BSC		0.354 BSC	
V1	4.500 BSC		0.177 BSC	
W	0.200 REF		0.008 REF	
X	1.000 REF		0.039 REF	



## 40-Pin Packages

### N SUFFIX PLASTIC DIP PACKAGE CASE 711-03 ISSUE C



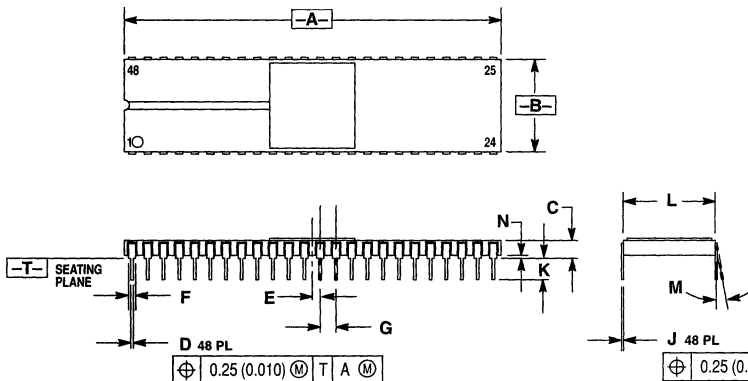
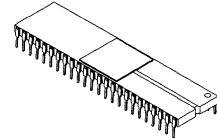
NOTES:

1. POSITIONAL TOLERANCE OF LEADS (D), SHALL BE WITHIN 0.25 (0.010) AT MAXIMUM MATERIAL CONDITION, IN RELATION TO SEATING PLANE AND EACH OTHER.
2. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
3. DIMENSION B DOES NOT INCLUDE MOLD FLASH

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	51.69	52.45	2.035	2.065
B	13.72	14.22	0.540	0.560
C	3.94	5.08	0.155	0.200
D	0.36	0.56	0.014	0.022
F	1.02	1.52	0.040	0.060
G	2.54 BSC 0.100 BSC			
H	1.65	2.16	0.065	0.085
J	0.20	0.38	0.008	0.015
K	2.92	3.43	0.115	0.135
L	15 24 BSC 0.600 BSC			
M	0°	15°	0°	15°
N	0.51	1.02	0.020	0.040

## 48-Pin Packages

### J SUFFIX CERAMIC DIP PACKAGE CASE 740-03 ISSUE B



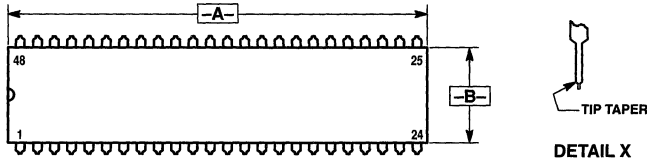
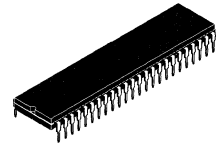
NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.

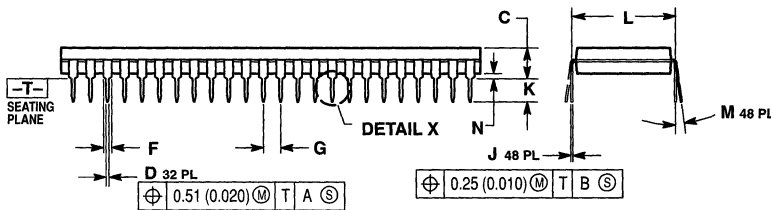
DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	2.376	2.424	60.36	61.56
B	0.576	0.604	14.64	15.34
C	0.120	0.127	3.05	4.31
D	0.015	0.021	0.381	0.533
E	0.050 BSC		1.27 BSC	
F	0.030	0.055	0.762	1.397
G	0.100 BSC 2.54 BSC			
J	0.008	0.013	0.204	0.330
K	0.100	0.165	2.54	4.19
L	0.600 BSC 15 24 BSC			
M	0°	10°	0°	10°
N	0.040	0.060	1.016	1.524

# 48-Pin Packages

## N SUFFIX PLASTIC DIP PACKAGE CASE 767-02 ISSUE B

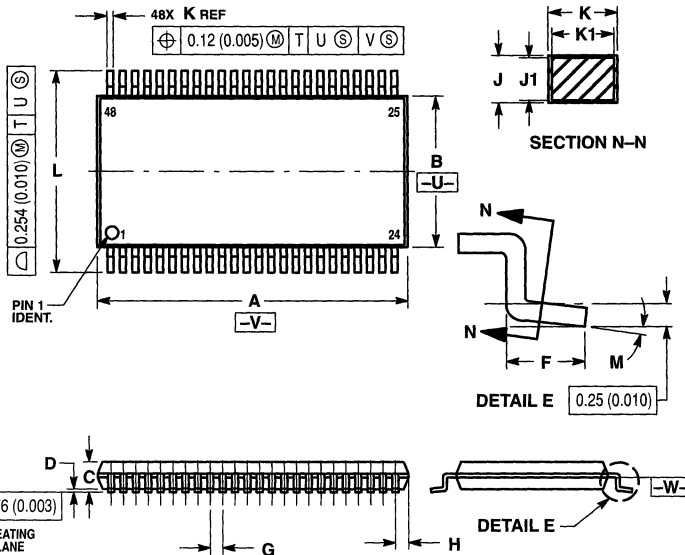


- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: INCH.
  3. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.
  4. DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH. MAXIMUM MOLD FLASH 0.25 (0.010).



DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	2.415	2.445	61.34	62.10
B	0.540	0.560	13.72	14.22
C	0.155	0.200	3.94	5.08
D	0.014	0.022	0.36	0.55
F	0.040	0.060	1.02	1.52
G	0.100 BSC	—	2.54 BSC	—
H	0.070 BSC	—	1.79 BSC	—
J	0.008	0.015	0.20	0.38
K	0.115	0.150	2.92	3.81
L	0.600 BSC	—	15.24 BSC	—
M	0°	15°	0°	15°
N	0.020	0.040	0.51	1.01

## DT SUFFIX PLASTIC TSSOP PACKAGE CASE 1201-01 ISSUE A

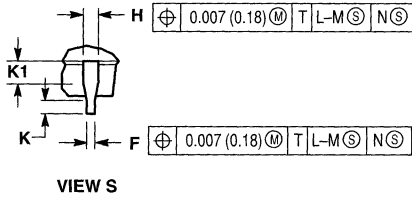
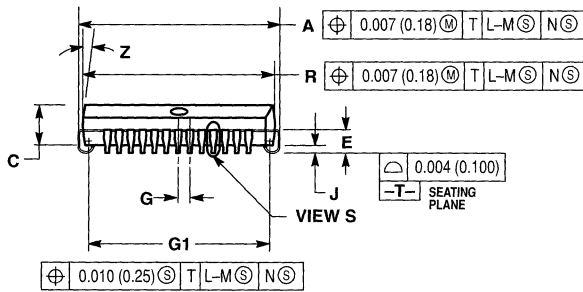
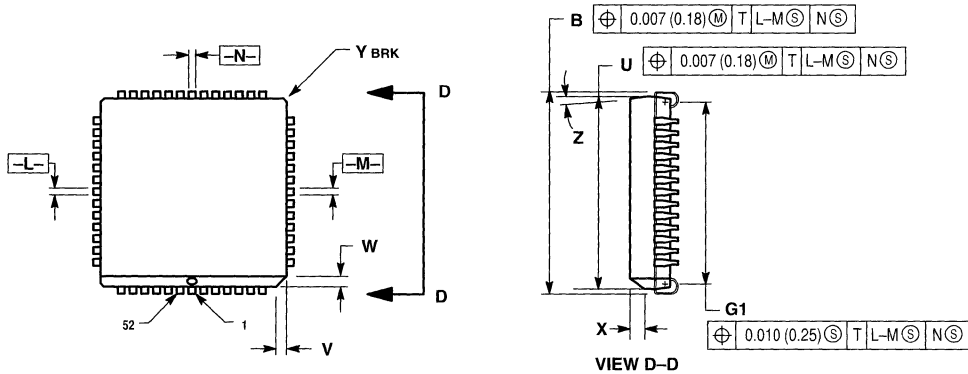


- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: MILLIMETER.
  3. DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
  4. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
  5. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
  6. DIMENSIONS A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	12.40	12.60	0.488	0.496
B	6.00	6.20	0.236	0.244
C	—	1.10	—	0.043
D	0.05	0.15	0.002	0.006
F	0.50	0.75	0.020	0.030
G	0.50 BSC	—	0.0197 BSC	—
H	0.37	—	0.015	—
J	0.09	0.20	0.004	0.008
J1	0.09	0.16	0.004	0.006
K	0.17	0.27	0.007	0.011
K1	0.17	0.23	0.007	0.009
L	7.95	8.25	0.313	0.325
M	0°	8°	0°	8°

# 52-Pin Packages

## FN SUFFIX PLASTIC PLCC PACKAGE CASE 778-02 ISSUE C

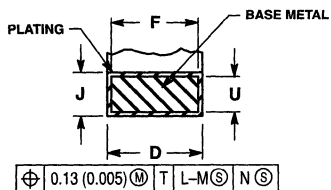
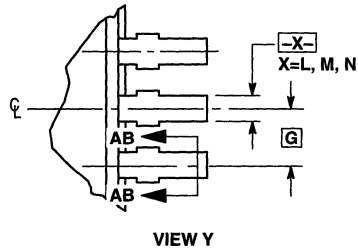
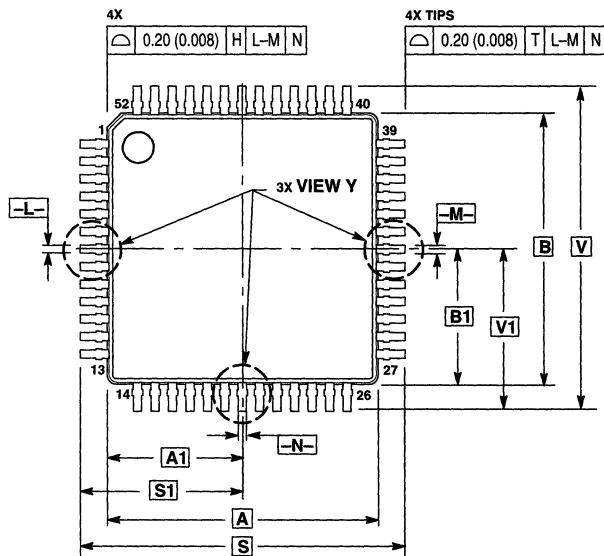


### NOTES:

- DATUMS -L-, -M-, AND -N- DETERMINED WHERE TOP OF LEAD SHOULDER EXITS PLASTIC BODY AT MOLD PARTING LINE.
- DIMENSION G1, TRUE POSITION TO BE MEASURED AT DATUM -T-, SEATING PLANE.
- DIMENSIONS R AND U DO NOT INCLUDE MOLD FLASH. ALLOWABLE MOLD FLASH IS 0.010 (0.250) PER SIDE.
- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: INCH.
- THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM BY UP TO 0.012 (0.300).
- DIMENSIONS R AND U ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.
- DIMENSION H DOES NOT INCLUDE DAMBAR PROTRUSION OR INTRUSION. THE DAMBAR PROTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE GREATER THAN 0.037 (0.940). THE DAMBAR INTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE SMALLER THAN 0.025 (0.635).

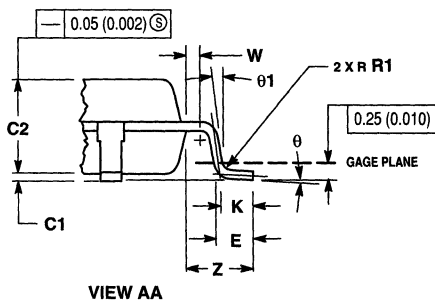
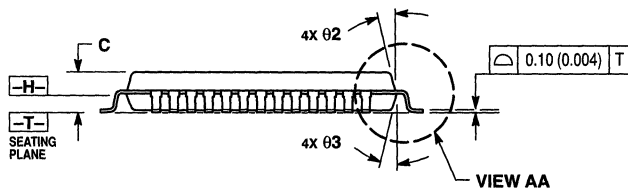
DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.785	0.795	19.94	20.19
B	0.785	0.795	19.94	20.19
C	0.165	0.180	4.20	4.57
E	0.090	0.110	2.29	2.79
F	0.013	0.019	0.33	0.48
G	0.050 BSC		1.27 BSC	
H	0.026	0.032	0.66	0.81
J	0.020	—	0.51	—
K	0.025	—	0.64	—
R	0.750	0.756	19.05	19.20
U	0.750	0.756	19.05	19.20
V	0.042	0.048	1.07	1.21
W	0.042	0.048	1.07	1.21
X	0.042	0.056	1.07	1.42
Y	—	0.020	—	0.50
Z	2°	10°	2°	10°
G1	0.710	0.730	18.04	18.54
K1	0.040	—	1.02	—

**FA SUFFIX**  
**PLASTIC TQFP PACKAGE**  
 CASE 848D-03  
 ISSUE C



**SECTION AB-AB**  
 ROTATED 90° CLOCKWISE

- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: MILLIMETER.
  3. DATUM PLANE -H- IS LOCATED AT BOTTOM OF LEAD AND IS COINCIDENT WITH THE LEAD WHERE THE LEAD EXITS THE PLASTIC BODY AT THE BOTTOM OF THE PARTING LINE.
  4. DATUMS -L-, -M- AND -N- TO BE DETERMINED AT DATUM PLANE -H-.
  5. DIMENSIONS S AND V TO BE DETERMINED AT SEATING PLANE -T-.
  6. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE PROTRUSION IS 0.25 (0.010) PER SIDE. DIMENSIONS A AND B DO INCLUDE MOLD MISMATCH AND ARE DETERMINED AT DATUM PLANE -H-.
  7. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. DAMBAR PROTRUSION SHALL NOT CAUSE THE LEAD WIDTH TO EXCEED 0.46 (0.018). MINIMUM SPACE BETWEEN PROTRUSION AND ADJACENT LEAD OR PROTRUSION 0.07 (0.003).

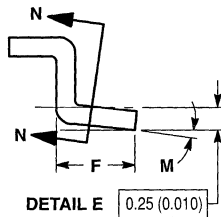
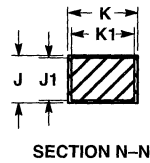
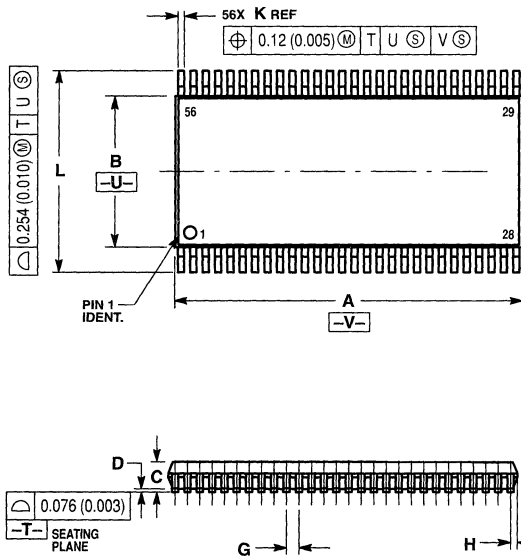


DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	10.00	BSC	0.394	BSC
A1	5.00	BSC	0.197	BSC
B	10.00	BSC	0.394	BSC
B1	5.00	BSC	0.197	BSC
C	—	1.70	—	0.067
C1	0.05	0.20	0.002	0.008
C2	1.30	1.50	0.051	0.059
D	0.20	0.40	0.008	0.016
E	0.45	0.75	0.018	0.030
F	0.22	0.35	0.009	0.014
G	0.65	BSC	0.026	BSC
J	0.07	0.20	0.003	0.008
K	0.50	REF	0.020	REF
R1	0.08	0.20	0.003	0.008
S	12.00	BSC	0.472	BSC
S1	6.00	BSC	0.236	BSC
U	0.09	0.16	0.004	0.006
V	12.00	BSC	0.472	BSC
V1	6.00	BSC	0.236	BSC
W	0.20	REF	0.008	REF
Z	1.00	REF	0.039	REF
Ø	0°	7°	0°	7°
Ø1	0°	—	0°	—
Ø2	12°	REF	12°	REF
Ø3	5°	13°	5°	13°



# 56-Pin Packages

## DT SUFFIX PLASTIC TSSOP PACKAGE CASE 1202-01 ISSUE A

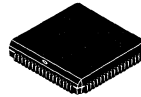
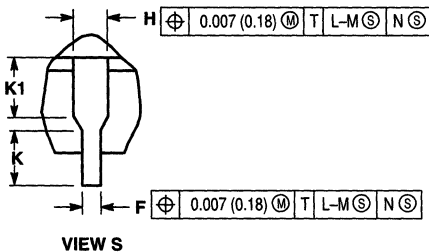
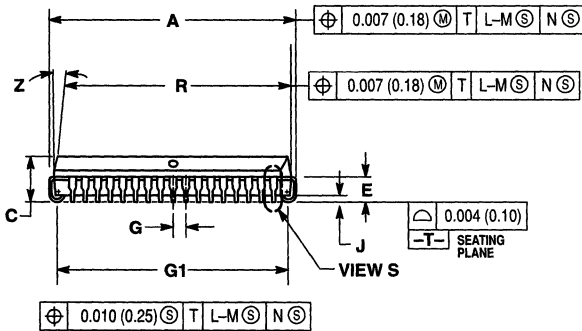
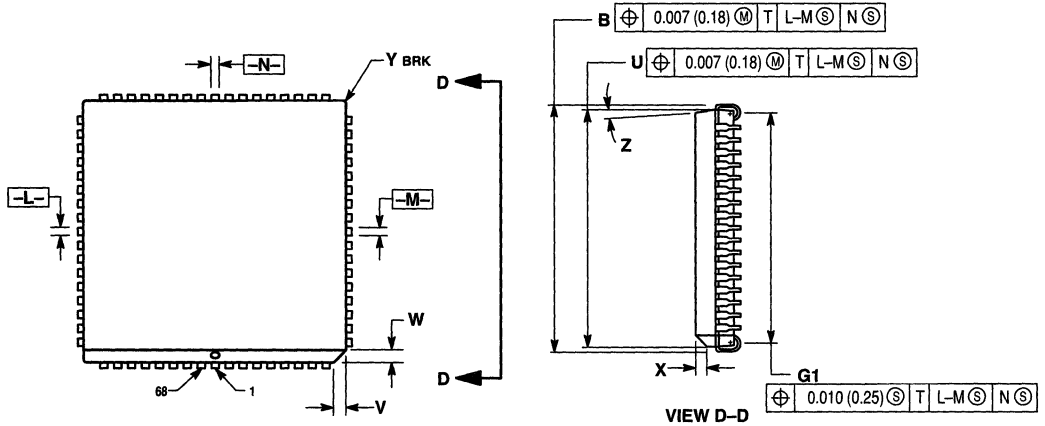


### NOTES:

- 1 DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982
- 2 CONTROLLING DIMENSION: MILLIMETER
- 3 DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE
- 4 DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION
- 5 TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
- 6 DIMENSIONS A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	13.90	14.10	0.547	0.555
B	6.00	6.20	0.236	0.244
C	—	1.10	—	0.043
D	0.05	0.15	0.002	0.006
F	0.50	0.75	0.020	0.030
G	0.50 BSC	—	0.0197 BSC	—
H	0.12	—	0.005	—
J	0.09	0.20	0.004	0.008
J1	0.09	0.16	0.004	0.006
K	0.17	0.27	0.007	0.011
K1	0.17	0.23	0.007	0.009
L	7.95	8.25	0.313	0.325
M	0°	8°	0°	8°

**FN SUFFIX**  
**PLASTIC PLCC PACKAGE**  
 CASE 779-02  
 ISSUE C

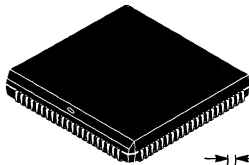


**NOTES:**

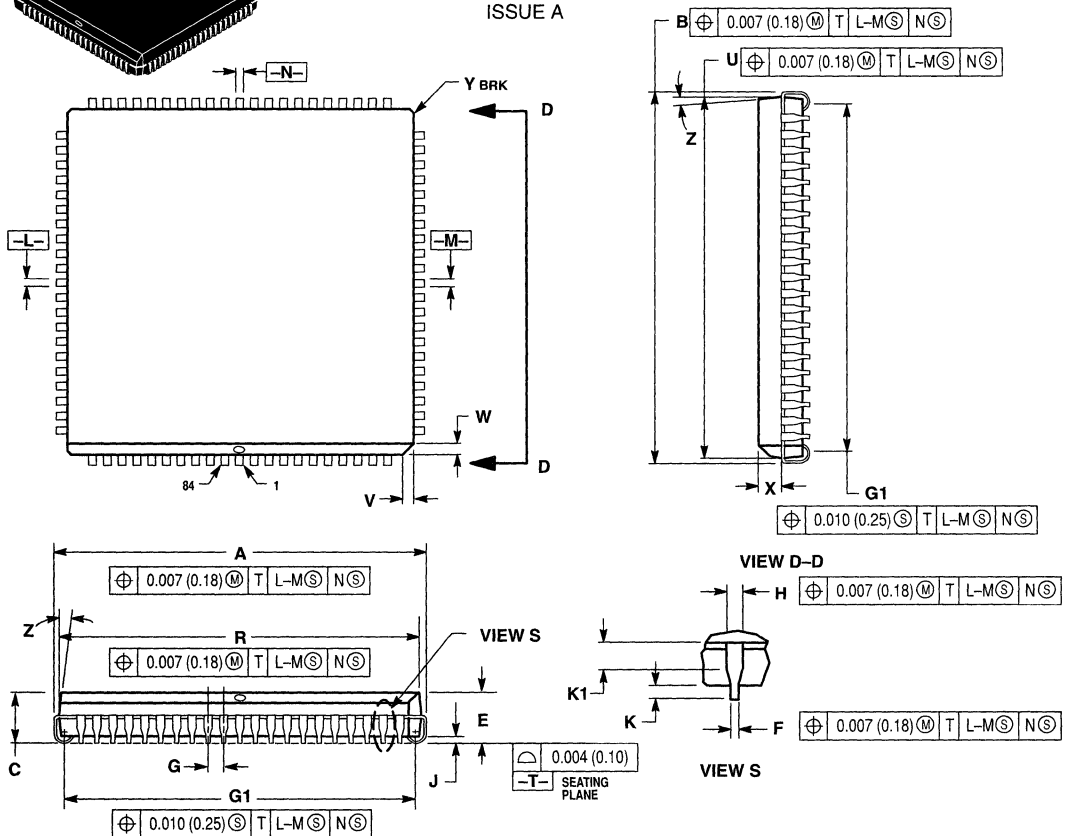
1. DATUMS -L-, -M-, AND -N- DETERMINED WHERE TOP OF LEAD SHOULDER EXITS PLASTIC BODY AT MOLD PARTING LINE.
2. DIMENSION G1, TRUE POSITION TO BE MEASURED AT DATUM -T-, SEATING PLANE.
3. DIMENSIONS R AND U DO NOT INCLUDE MOLD FLASH. ALLOWABLE MOLD FLASH IS 0.010 (0.250) PER SIDE.
4. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
5. CONTROLLING DIMENSION: INCH.
6. THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM BY UP TO 0.012 (0.300). DIMENSIONS R AND U ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.
7. DIMENSION H DOES NOT INCLUDE DAMBAR PROTRUSION OR INTRUSION. THE DAMBAR PROTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE GREATER THAN 0.037 (0.940). THE DAMBAR INTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE SMALLER THAN 0.025 (0.635).

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.985	0.995	25.02	25.27
B	0.985	0.995	25.02	25.27
C	0.165	0.180	4.20	4.57
E	0.090	0.110	2.29	2.79
F	0.013	0.019	0.33	0.48
G	0.050 BSC		1.27 BSC	
H	0.026	0.032	0.66	0.81
J	0.020	---	0.51	---
K	0.025	---	0.64	---
R	0.950	0.956	24.13	24.28
U	0.950	0.956	24.13	24.28
V	0.042	0.048	1.07	1.21
W	0.042	0.048	1.07	1.21
X	0.042	0.056	1.07	1.42
Y	---	0.020	---	0.50
Z	2°	10°	2°	10°
G1	0.910	0.930	23.12	23.62
K1	0.040	---	1.02	---

**Programmable Array  
84-Pin Package**



**FN SUFFIX  
PLASTIC PLCC PACKAGE  
CASE 780-01  
ISSUE A**

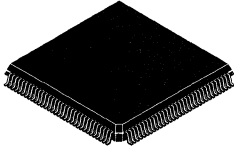


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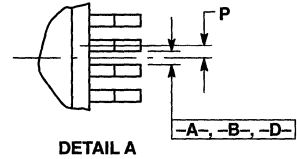
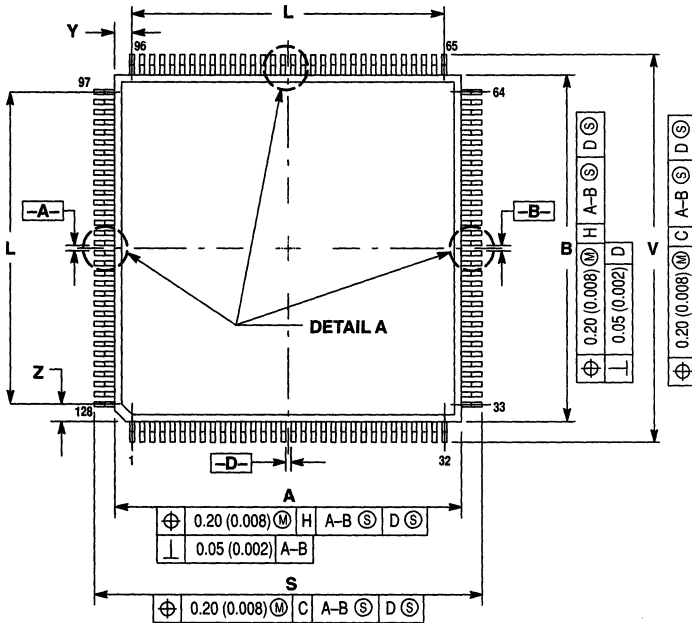
- DATUMS -L-, -M-, -N-, AND -P- DETERMINED WHERE TOP OF LEAD SHOULDER EXITS PACKAGE BODY AT MOLD PARTING LINE
- DIMENSION G1, TRUE POSITION TO BE MEASURED AT DATUM -T-, SEATING PLANE.
- DIMENSIONS R AND U DO NOT INCLUDE MOLD FLASH. ALLOWABLE MOLD FLASH IS 0.010 (0.25) PER SIDE.
- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: INCH.
- THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM BY UP TO 0.012 (0.300). DIMENSIONS R AND U ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.
- DIMENSION H DOES NOT INCLUDE DAMBAR PROTRUSION OR INTRUSION. THE DAMBAR PROTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE GREATER THAN 0.037 (0.94). THE DAMBAR INTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE SMALLER THAN 0.025 (0.635).

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	1.185	1.195	30.10	30.35
B	1.185	1.195	30.10	30.35
C	0.165	0.180	4.20	4.57
E	0.090	0.110	2.29	2.79
F	0.013	0.019	0.33	0.48
G	0.050 BSC 1.27 BSC			
H	0.026	0.032	0.66	0.81
J	0.020	—	0.51	—
K	0.025	—	0.64	—
R	1.150	1.156	29.21	29.36
U	1.150	1.156	29.21	29.36
V	0.042	0.048	1.07	1.21
W	0.042	0.048	1.07	1.21
X	0.042	0.056	1.07	1.42
Y	—	0.020	—	0.50
Z	2°		10°	
G1	1.110	1.130	28.20	28.70
K1	0.040	—	1.02	—

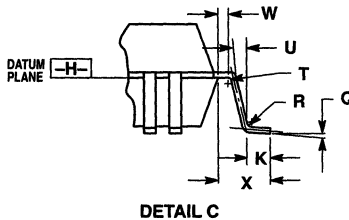
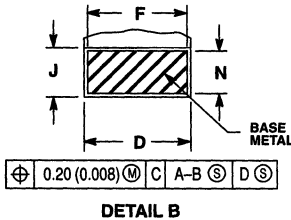
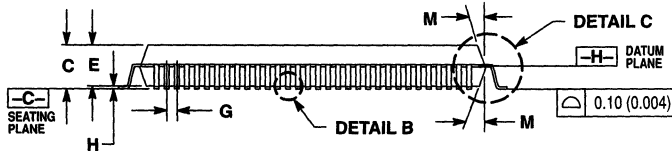
**Programmable Array  
128-Pin Package**



**DD SUFFIX  
PLASTIC QFP PACKAGE  
CASE 862A-02  
ISSUE B**



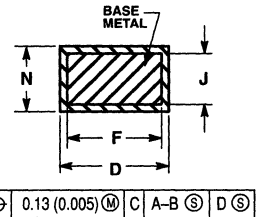
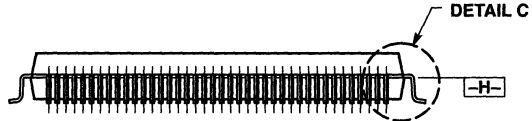
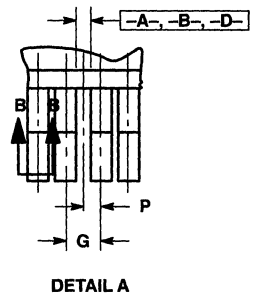
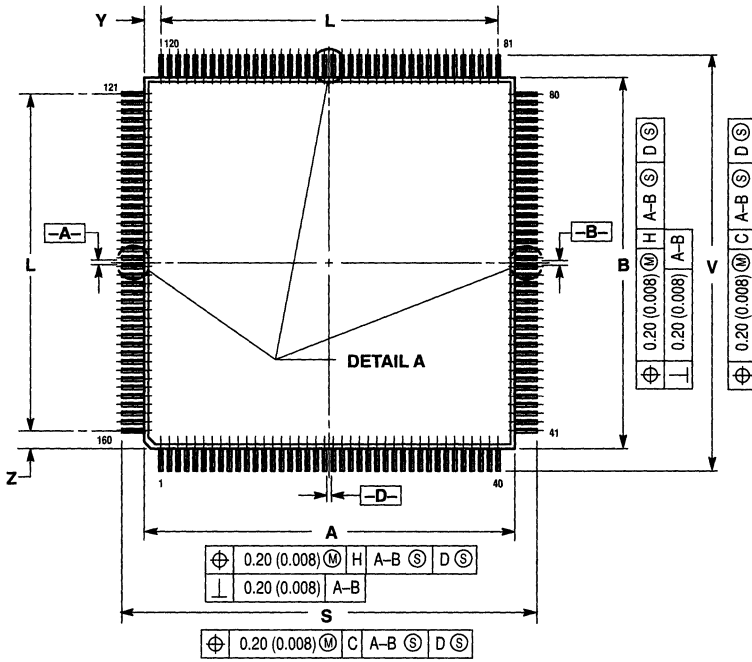
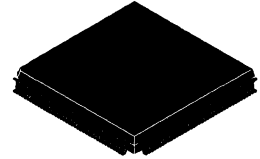
- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: MILLIMETER
  3. DATUM PLANE -H- IS LOCATED AT BOTTOM OF LEAD AND IS COINCIDENT WITH THE LEAD WHERE THE LEAD EXITS THE PLASTIC BODY AT THE BOTTOM OF THE PARTING LINE.
  4. DATUMS -A-, -B- AND -D- TO BE DETERMINED AT DATUM PLANE -H-.
  5. DIMENSIONS S AND V TO BE DETERMINED AT SEATING PLANE -C-.
  6. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE PROTRUSION IS 0.25 (0.010) PER SIDE. DIMENSIONS A AND B DO INCLUDE MOLD MISMATCH AND ARE DETERMINED AT DATUM PLANE -H-.
  7. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OF THE FOOT.



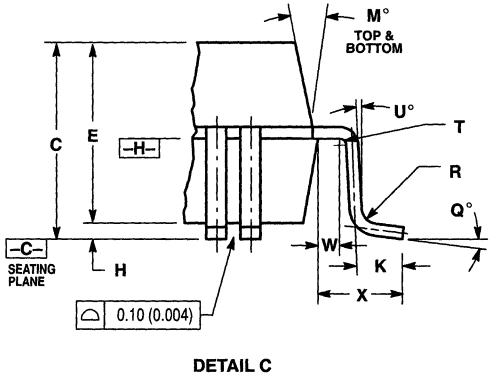
DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	27.90	28.10	1.098	1.106
B	27.90	28.10	1.098	1.106
C	—	4.07	—	0.160
D	0.30	0.45	0.012	0.018
E	3.17	3.67	0.125	0.144
F	0.30	0.40	0.012	0.016
G	0.80 BSC	—	0.032 BSC	—
H	0.25	0.35	0.010	0.014
J	0.13	0.23	0.005	0.009
K	0.65	0.95	0.026	0.037
L	24.80 REF	—	0.976 REF	—
M	5°	16°	5°	16°
N	0.13	0.17	0.005	0.007
P	0.40 BSC	—	0.016 BSC	—
Q	0°	7°	0°	7°
R	0.13	0.30	0.005	0.012
S	30.95	31.45	1.219	1.238
T	0.13	—	0.005	—
U	0°	—	0°	—
V	30.95	31.45	1.219	1.238
W	0.40	—	0.016	—
X	1.60 REF	—	0.063 REF	—
Y	1.60 REF	—	0.063 REF	—
Z	1.60 REF	—	0.063 REF	—

**Programmable Array  
160-Pin Package**

**DH SUFFIX  
PLASTIC QFP PACKAGE  
CASE 864A-03  
ISSUE C**



**SECTION B-B**

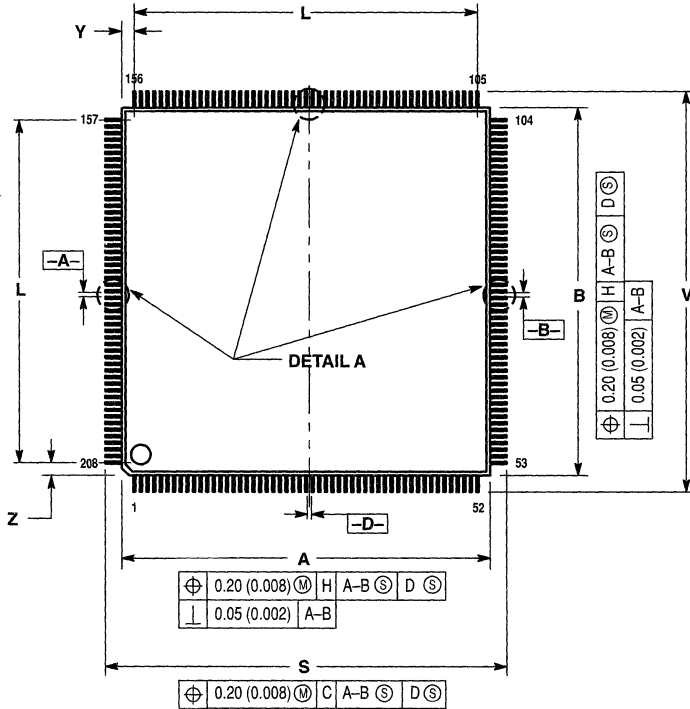
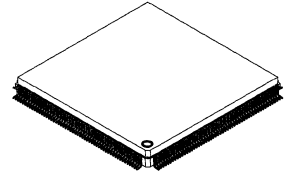


- NOTES:
- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  - CONTROLLING DIMENSION: MILLIMETER.
  - DATUM PLANE -H- IS LOCATED AT BOTTOM OF LEAD AND IS COINCIDENT WITH THE LEAD WHERE THE LEAD EXITS THE PLASTIC BODY AT THE BOTTOM OF THE PARTING LINE.
  - DATUMS -A-, -B- AND -D- TO BE DETERMINED AT DATUM PLANE -H-.
  - DIMENSIONS S AND V TO BE DETERMINED AT SEATING PLANE -C-.
  - DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE PROTRUSION IS 0.25 (0.010) PER SIDE. DIMENSIONS A AND B DO INCLUDE MOLD MISMATCH AND ARE DETERMINED AT DATUM PLANE -H-.
  - DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	27.90	28.10	1.098	1.106
B	27.90	28.10	1.098	1.106
C	3.35	3.85	0.132	0.152
D	0.22	0.38	0.009	0.015
E	3.20	3.50	0.126	0.138
F	0.22	0.33	0.009	0.013
G	0.65 BSC		0.025 REF	
H	0.25	0.35	0.010	0.014
J	0.11	0.23	0.004	0.009
K	0.70	0.90	0.028	0.035
L	25.35 REF		0.998 REF	
M	5°	16°	5°	16°
N	0.11	0.19	0.004	0.007
P	0.325 BSC		0.013 BSC	
Q	0°	7°	0°	7°
R	0.13	0.30	0.005	0.012
S	31.00	31.40	1.220	1.236
T	0.13	—	0.005	—
U	0°	—	0°	—
V	31.00	31.40	1.220	1.236
W	0.40	—	0.016	—
X	1.60 REF		0.063 REF	
Y	1.33 REF		0.052 REF	
Z	1.33 REF		0.052 REF	

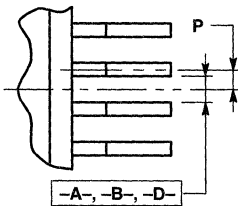
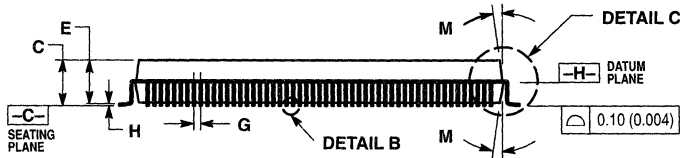
**Programmable Array  
208-Pin Package**

**DK SUFFIX  
PLASTIC QFP PACKAGE  
CASE 872A-01  
ISSUE O**

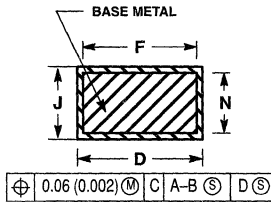


- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: MILLIMETER.
  3. DATUM PLANE -H- IS LOCATED AT BOTTOM OF LEAD AND IS COINCIDENT WITH THE LEAD WHERE THE LEAD EXITS THE PLASTIC BODY AT THE BOTTOM OF THE PARTING LINE.
  4. DATUMS -A-, -B- AND -D- TO BE DETERMINED AT DATUM PLANE -H-.
  5. DIMENSIONS S AND V TO BE DETERMINED AT SEATING PLANE -C-.
  6. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE PROTRUSION IS 0.25 (0.010) PER SIDE. DIMENSIONS A AND B DO INCLUDE MOLD MISMATCH AND ARE DETERMINED AT DATUM PLANE -H-.
  7. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. DAMBAR PROTRUSION SHALL NOT CAUSE THE D DIMENSION TO EXCEED 0.38 (0.015).

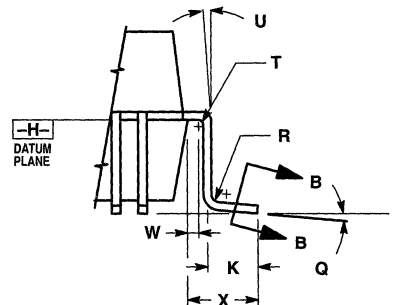
DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	27.90	28.10	1.098	1.106
B	27.90	28.10	1.098	1.106
C	3.45	4.10	0.136	0.161
D	0.14	0.30	0.005	0.012
E	3.20	3.60	1.26	0.142
F	0.14	0.26	0.005	0.010
G	0.30 BSC	0.020 BSC		
H	0.25	0.35	0.010	0.014
J	0.09	0.20	0.003	0.008
K	0.70	0.90	0.027	0.036
L	25.50 REF	1.004 REF		
M	5°	9°	5°	9°
N	0.09	0.18	0.003	0.007
P	0.25 BSC	0.010 BSC		
Q	0°	7°	0°	7°
R	0.13	0.30	0.005	0.012
S	31.00	31.40	1.220	1.236
T	0.13	—	0.005	—
U	0°	—	0°	—
V	31.00	31.40	1.220	1.236
W	0.40	—	0.016	—
X	1.60 REF	0.063 REF		
Y	1.25 REF	0.049 REF		
Z	1.25 REF	0.049 REF		



DETAIL A



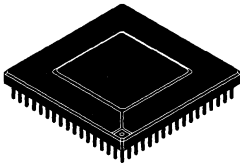
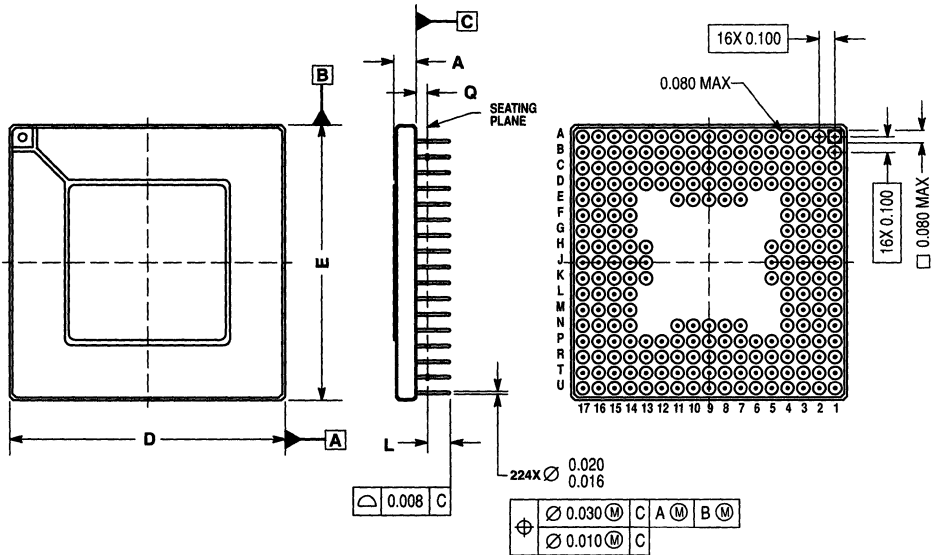
DETAIL B  
SECTION B-B  
ROTATED 7° CCW



DETAIL C

**Programmable Array  
224-Pin Package**

**KE SUFFIX  
PIN GRID ARRAY PACKAGE  
CASE 860F-01  
ISSUE O**

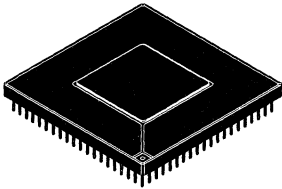
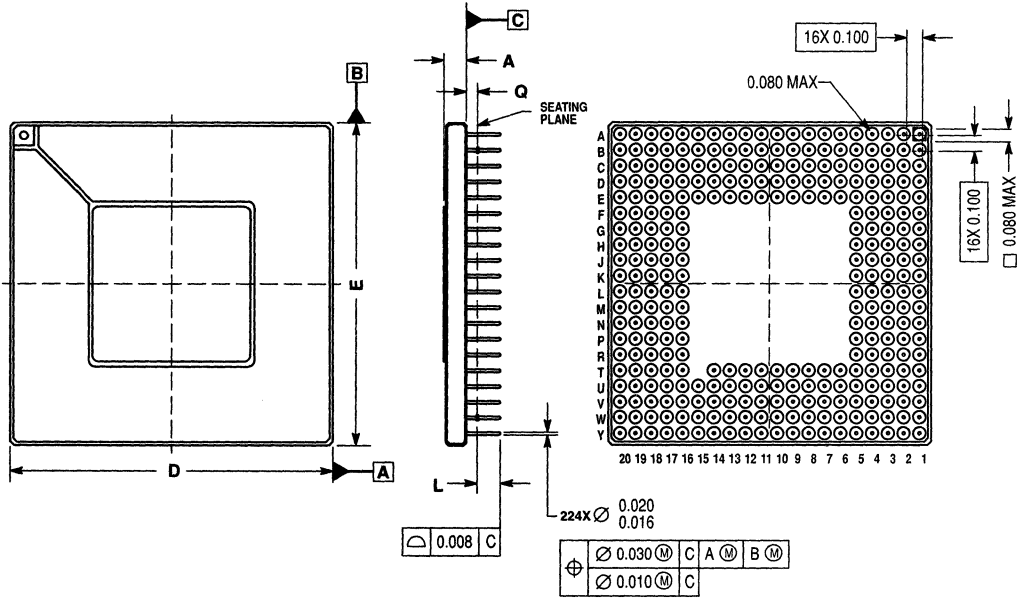


- NOTES:  
 1. DIMENSIONS ARE IN INCHES.  
 2. INTERPRET DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994.  
 3. MINIMUM SPACING BETWEEN CONDUCTORS SHALL BE 0.020.

DIM	INCHES	
	MIN	MAX
A	0.070	0.145
D	1.740	1.780
E	1.740	1.780
L	0.100	0.200
Q	0.045	0.075

**Programmable Array  
299-Pin Package**

**HV SUFFIX  
PIN GRID ARRAY PACKAGE  
CASE 861B-01  
ISSUE O**



**NOTES:**

1. DIMENSIONS ARE IN INCHES.
2. INTERPRET DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994.
3. MINIMUM SPACING BETWEEN CONDUCTORS SHALL BE 0.020.

DIM	INCHES	
	MIN	MAX
A	0.070	0.145
D	2.040	2.080
E	2.040	2.080
L	0.100	0.200
Q	0.045	0.075
S	0.050	BSC



# Packaging Information

## Surface Mount

### Why Surface Mount?

Surface Mount Technology is utilized to offer answers to many problems that have been created in the use of insertion technology.

Limitations have been reached with insertion packages and PC board technology. Surface Mount Technology offers the opportunity to continue to advance the state-of-the-art designs that cannot be accomplished with Insertion Technology.

Surface Mount Packages allow more optimum device performance with the smaller Surface Mount configuration. Internal lead lengths, parasitic capacitance and inductance that placed limitations on chip performance have been reduced.

The lower profile of Surface Mount Packages allows more boards to be utilized in a given amount of space. They are

stacked closer together and utilize less total volume than insertion populated PC boards.

Printed circuit costs are lowered with the reduction of the number of board layers required. The elimination or reduction of the number of plated through holes in the board, contributes significantly to lower PC board prices.

Automatic placement equipment is available that can place Surface Mount components at the rate of a few thousand per hour to hundreds of thousands of components per hour.

Surface Mount Technology is cost effective, allowing the manufacturer the opportunity to produce smaller units and/or offer increased functions with the same size product.

Surface Mount assembly does not require the preparation of components that are common on insertion technology lines. Surface Mount components are sent directly to the assembly line, eliminating an intermediate step.

## Pin Conversion Tables

### Dual-In-Line Package to PLCC Pin Conversion Data

The following table gives the equivalent I/O pinouts of Dual-In-Line Package (DIP) configuration and Plastic Leaded Chip Carrier (PLCC) packages.\*

#### Conversion Tables

8 PIN DIP	1	2	3	4	5	6	7	8
20 PIN PLCC	2	5	7	10	12	15	17	20

14 PIN DIP	1	2	3	4	5	6	7	8	9	10	11	12	13	14
20 PIN PLCC	2	3	4	6	8	9	10	12	13	14	16	18	19	20

16 PIN DIP	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
20 PIN PLCC	2	3	4	5	7	8	9	10	12	13	14	15	17	18	19	20

20 PIN DIP	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20
20 PIN PLCC	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20

24 PIN DIP	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24
28 PIN PLCC	2	3	4	5	6	7	9	10	11	12	13	14	16	17	18	19	20	21	23	24	25	26	27	28

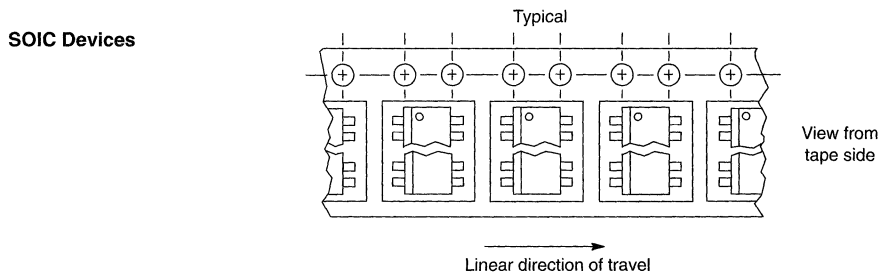
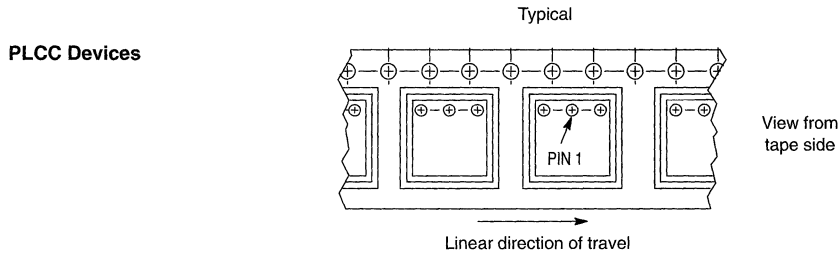
\* The MC1648 has a Non-Standard Conversion Table. For more information, refer to the Motorola MECL Data Book, DL122/D.

# Tape and Reel

## Logic Integrated Circuits

Motorola's tape and reel packaging fully conforms to the latest EIA RS-481A specification. The antistatic embossed tape provides a secure cavity sealed with a peel-back cover tape.

### Mechanical Polarization



### General Information

— Reel Size 13 inch (330 mm) Suffix: R2 — Units/Reel 500 to 5000 (see table)  
 — Tape Width 12 mm to 24 mm (see table)

### Ordering Information

To order devices which are to be delivered in Tape and Reel, add the suffix R2 to the device number being ordered.

### Tape and Reel Data

Device Type	Tape Width (mm)	Device/Reel	Reel Size (inch)	Min Lot Size Per Part No. Tape and Reel
PLCC-20	16	1,000	13	3,000
PLCC-28	24	500	13	500
SO-8	12	2,500	13	5,000
SO-14	16	2,500	13	5,000
SO-16	16	2,500	13	5,000
SO-16 Wide	16	1,000	13	5,000
SO-20 Wide	24	1,000	13	5,000

# Analog and Interface Integrated Circuits

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## In Brief . . .

Motorola Analog and Interface Integrated Circuits cover a much broader range of products than the traditional op amps/regulators/consumer—image associated with Analog suppliers. Analog circuit technology currently influences the design and architecture of equipment for all major markets. As with other integrated circuit technologies, Analog circuit design techniques and processes have been continually refined and updated to meet the needs of these diversified markets.

Operational amplifiers have utilized JFET inputs for improved performance, plus innovative design and trimming concepts have evolved for improved high performance and precision characteristics. In analog power ICs, basic voltage regulators have been refined to include higher current and voltage levels, low dropout regulators, and more precise three-terminal fixed and adjustable voltages. The power area continues to expand into switching regulators, power supply control and supervisory circuits, motor controllers, and battery charging controllers.

Analog designs also offer a wide array of line drivers, receivers and transceivers for many of the EIA, European, IEEE and IBM interface standards. Peripheral drivers for a variety of devices are also offered. In addition to these key interface functions, hard disk drive read channel circuits, 10BASE-T and Ethernet circuits are also available.

In Data Conversion, a high performance video speed flash converter is available, as well as a variety of CMOS and Sigma-Delta converters. Analog circuit technology has also provided precision low-voltage references for use in Data Conversion and other low temperature drift applications.

A host of special purpose analog devices have also been developed. These circuits find applications in telecommunications, radio, television, automotive, RF communications, and data transmission. These products have reduced the cost of RF communications, and have provided capabilities in telecommunications which make the telephone line convenient for both voice and data communications. Analog developments have also reduced the many discrete components formerly required for consumer functions to a few IC packages and have made significant contributions to the rapidly growing market for electronics in automotive applications.

The table of contents provides a perspective of the many markets served by Analog/Interface ICs and of Motorola's involvement in these areas.

Amplifiers and Comparators . . . . .	4.1-1
Power Supply Circuits . . . . .	4.2-1
Power/Motor Control Circuits . . . . .	4.3-1
Voltage References . . . . .	4.4-1
Data Conversion . . . . .	4.5-1
Interface Circuits . . . . .	4.6-1
Communication Circuits . . . . .	4.7-1
Consumer Electronic Circuits . . . . .	4.8-1
Automotive Electronic Circuits . . . . .	4.9-1
Other Analog Circuits . . . . .	4.10-1
Tape and Reel Options . . . . .	4.11-1



# Amplifiers and Comparators

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## In Brief . . .

For over two decades, Motorola has continually refined and updated integrated circuit technologies, analog circuit design techniques and processes in response to the needs of the marketplace. The enhanced performance of newer operational amplifiers and comparators has come through innovative application of these technologies, designs and processes. Some early designs are still available but are giving way to the new, higher performance operational amplifier and comparator circuits. Motorola has pioneered in JFET inputs, low temperature coefficient input stages, Miller loop compensation, all NPN output stages, dual-doublet frequency compensation and analog "in-the-package" trimming of resistors to produce superior high performance operational amplifiers and comparators, operating in many cases from a single supply with low input offset, low noise, low power, high output swing, high slew rate and high gain-bandwidth product at reasonable cost to the customer.

Present day operational amplifiers and comparators find applications in all market segments including motor controls, instrumentation, aerospace, automotive, telecommunications, medical, and consumer products.

	<b>Page</b>
Operational Amplifiers . . . . .	4.1-2
Single . . . . .	4.1-2
Dual . . . . .	4.1-3
Quad . . . . .	4.1-4
High Frequency Amplifiers . . . . .	4.1-5
AGC . . . . .	4.1-5
Miscellaneous Amplifiers . . . . .	4.1-6
Bipolar . . . . .	4.1-6
CMOS . . . . .	4.1-6
Comparators . . . . .	4.1-7
Single . . . . .	4.1-7
Dual . . . . .	4.1-7
Quad . . . . .	4.1-7
Package Overview . . . . .	4.1-8

# Operational Amplifiers

Motorola offers a broad line of bipolar operational amplifiers to meet a wide range of applications. From low-cost industry-standard types to high precision circuits, the span encompasses a large range of performance capabilities. These Analog integrated circuits are available as single, dual

and quad monolithic devices in a variety of temperature ranges and package styles. Most devices may be obtained in unencapsulated "chip" form as well. For price and delivery information on chips, please contact your Motorola Sales Representative or Distributor.

**Table 1. Single Operational Amplifiers**

Device	$I_B$ ( $\mu A$ )	$V_{IO}$ (mV)	$TC_{V_{IO}}$ ( $\mu V/^\circ C$ )	$I_{IO}$ (nA)	$A_{vol}$ (V/mV)	BW ( $A_V = 1$ ) (MHz)	SR ( $A_V = 1$ ) (V/ $\mu s$ )	Supply Voltage (V)		Description	Suffix/ Package
	Max	Max	Typ	Max	Min	Typ	Typ	Min	Max		
<b>Noncompensated</b>											
<b>Commercial Temperature Range (0°C to +70°C)</b>											
LM301A	0.25	7.5	10	50	25	1.0	0.5	$\pm 3.0$	$\pm 18$	General Purpose	N/626, D/751
LM308A	7.0	0.5	5.0	1.0	80	1.0	0.3	$\pm 3.0$	$\pm 18$	Precision	N/626, D/751
<b>Industrial Temperature Range (-25°C to +85°C)</b>											
LM201A	0.075	2.0	10	10	50	1.0	0.5	$\pm 3.0$	$\pm 22$	General Purpose	N/626, D/751
<b>Internally Compensated</b>											
<b>Commercial Temperature Range (0°C to +70°C)</b>											
LF351	200 pA	10	10	100 pA	25	4.0	13	$\pm 5.0$	$\pm 18$	JFET Input	N/626, D/751
LF411C	200 pA	2.0	10	100 pA	25	8.0	25	+5.0	$\pm 22$	JFET Input, Low Offset, Low Drift	N/626, D/751
MC1436, C	0.04	10	12	10	70	1.0	2.0	$\pm 15$	$\pm 34$	High Voltage	P/626, D/751
MC1741C	0.5	6.0	15	200	20	1.0	0.5	$\pm 3.0$	$\pm 18$	General Purpose	P/626, D/751
MC1776C	0.003	6.0	15	3.0	100	1.0	0.2	$\pm 1.2$	$\pm 18$	$\mu$ Power, Programmable	P/626, D/751
MC3476	0.05	6.0	15	25	50	1.0	0.2	$\pm 1.5$	$\pm 18$	Low Cost, $\mu$ Power, Programmable	P/626
MC34001	200 pA	10	10	100 pA	25	4.0	13	$\pm 5.0$	$\pm 18$	JFET Input	P/626, D/751
MC34001B	200 pA	5.0	10	100 pA	50	4.0	13	$\pm 5.0$	$\pm 18$	JFET Input	P/626, D/751
MC34071	0.5	5.0	10	75	25	4.5	10	+3.0	+44	High Performance	P/626, D/751
MC34071A	500 nA	3.0	10	50	50	4.5	10	+3.0	+44	Single Supply	P/626, D/751
MC34080B	200 pA	1.0	10	100 pA	25	16	55	$\pm 5.0$	$\pm 22$	Decompensated	P/626, D/751
MC34081B	200 pA	1.0	10	100 pA	25	8.0	30	$\pm 5.0$	$\pm 22$	High Speed, JFET Input	P/626, D/751
MC34181	0.1 nA	2.0	10	0.05	25	4.0	10	$\pm 2.5$	$\pm 18$	Low Power, JFET Input	P/626
TL071AC	200 pA	6.0	10	50 pA	50	4.0	13	$\pm 5.0$	$\pm 18$	Low Noise, JFET Input	P/626, D/751
TL071C	200 pA	10	10	50 pA	25	4.0	13	$\pm 5.0$	$\pm 18$	Low Noise, JFET Input	P/626, D/751
TL081AC	200 pA	6.0	10	100 pA	50	4.0	13	$\pm 5.0$	$\pm 18$	JFET Input	P/626, D/751
TL081C	400 pA	15	10	200 pA	25	4.0	13	$\pm 5.0$	$\pm 18$	JFET Input	P/626, D/751
<b>Automotive Temperature Range (-40°C to +85°C)</b>											
MC33071	0.5	5.0	10	75	25	4.5	10	+3.0	+44	High Performance	P/626, D/751
MC33071A	500 nA	3.0	10	50	50	4.5	10	+3.0	+44	Single Supply	P/626, D/751
MC33171	0.1	4.5	10	20	50	1.8	2.1	+3.0	+44	Low Power, Single Supply	P/626, D/751
MC33181	0.1 nA	2.0	10	0.05	25	4.0	10	$\pm 2.5$	$\pm 18$	Low Power, JFET Input	P/626, D/751
<b>Extended Automotive Temperature Range (-40°C to +105°C)</b>											
MC33201	250 nA	9.0	2.0	100	50	2.2	1.0	$\pm 0.9$	$\pm 6.0$	Low V Rail-to-Rail	P/626, D/751
<b>Military Temperature Range (-55°C to +125°C)</b>											
MC33201	400 nA	9.0	2.0	200	50	2.2	1.0	$\pm 0.9$	$\pm 6.0$	Low V Rail-to-Rail	P/626, D/751

**Table 2. Dual Operational Amplifiers**

Device	$I_{IB}$ ( $\mu$ A)	$V_{IO}$ (mV)	$TC_{VIO}$ ( $\mu$ V/ $^{\circ}$ C)	$I_{IO}$ (nA)	$A_{vol}$ (V/mV)	BW ( $A_V = 1$ ) (MHz)	SR ( $A_V = 1$ ) (V/ $\mu$ s)	Supply Voltage (V)		Description	Suffix/ Package
	Max	Max	Typ	Max	Min	Typ	Typ	Min	Max		
<b>Internally Compensated</b>											
<b>Commercial Temperature Range (0<math>^{\circ}</math>C to +70<math>^{\circ}</math>C)</b>											
LF353	200 pA	10	10	100 pA	25	4.0	13	$\pm$ 5.0	$\pm$ 18	JFET Input	N/626, D/751
LF412C	200 pA	3.0	10	100 pA	25	4.0	13	$\pm$ 5.0	$\pm$ 18	JFET Input, Low Offset, Low Drift	N/626, D/751
LF442C	100 pA	5.0	10	50 pA	25	2.0	6.0	$\pm$ 5.0	$\pm$ 18	Low Power, JFET Input	N/626
LM358	0.25	6.0	7.0	50	25	1.0	0.6	$\pm$ 1.5	$\pm$ 18	Single Supply, Low Power Consumption	N/626, D/751
LM833	1.0	5.0	2.0	200	31.6	15	7.0	$\pm$ 2.5	$\pm$ 18	Low Noise, Audio	N/626, D/751
MC1458	0.5	6.0	10	200	20	1.1	0.8	$\pm$ 3.0	$\pm$ 18	Dual MC1741	P1/626, D/751
MC1458C	0.7	10	10	300	20	1.1	0.8	$\pm$ 3.0	$\pm$ 18	General Purpose	P1/626, D/751
MC3458	0.5	10	7.0	50	20	1.0	0.6	$\pm$ 1.5	$\pm$ 18	Split Supplies, Single Supply, Low Crossover Distortion	P1/626, D/751
MC4558AC	0.5	5.0	10	200	50	2.8	1.6	$\pm$ 3.0	$\pm$ 22	High Frequency	P1/626
MC4558C	0.5	6.0	10	200	20	2.8	1.6	$\pm$ 3.0	$\pm$ 18	High Frequency	P1/626, D/751
MC34002	100 pA	10	10	100 pA	25	4.0	13	$\pm$ 5.0	$\pm$ 18	JFET Input	P/626, D/751
MC34002B	100 pA	5.0	10	70 pA	25	4.0	13	$\pm$ 5.0	$\pm$ 18	JFET Input	P/626, D/751
MC34072	0.5	5.0	10	75	25	4.5	10	$\pm$ 3.0	$\pm$ 44	High Performance	P/626, D/751
MC34072A	500 nA	3.0	10	50	50	4.5	10	$\pm$ 3.0	$\pm$ 44	Single Supply	P/626, D/751
MC34082	200 pA	3.0	10	100 pA	25	8.0	30	$\pm$ 5.0	$\pm$ 22	High Speed, JFET Input	P/626
MC34083B	200 pA	3.0	10	100 pA	25	16	55	$\pm$ 5.0	$\pm$ 22	Decompensated	P/626
MC34182	0.1 nA	3.0	10	0.05	25	4.0	10	$\pm$ 2.5	$\pm$ 18	Low Power, JFET Input	P/626, D/751
TL062AC	200 pA	6.0	10	100 pA	4.0	2.0	6.0	$\pm$ 2.5	$\pm$ 18	Low Power, JFET Input	P/626, D/751
TL062C	200 pA	15	10	200 pA	4.0	2.0	6.0	$\pm$ 2.5	$\pm$ 18	Low Power, JFET Input	P/626, D/751
TL072AC	200 pA	6.0	10	50 pA	50	4.0	13	$\pm$ 5.0	$\pm$ 18	Low Noise, JFET Input	P/626, D/751
TL072C	200 pA	10	10	50 pA	25	4.0	13	$\pm$ 5.0	$\pm$ 18	Low Noise, JFET Input	P/626, D/751
TL082AC	200 pA	6.0	10	100 pA	50	4.0	13	$\pm$ 5.0	$\pm$ 18	JFET Input	P/626, D/751
TL082C	400 pA	15	10	200 pA	25	4.0	13	$\pm$ 5.0	$\pm$ 18	JFET Input	P/626, D/751
<b>Industrial Temperature Range (-25<math>^{\circ}</math>C to +85<math>^{\circ}</math>C)</b>											
LM258	0.15	5.0	10	30	50	1.0	0.6	$\pm$ 1.5	$\pm$ 18	Split or Single Supply Op Amp	N/626, D/751
<b>Automotive Temperature Range (-40<math>^{\circ}</math>C to +85<math>^{\circ}</math>C)</b>											
MC3358	5.0	8.0	10	75	20	1.0	0.6	$\pm$ 1.5	$\pm$ 18	Split or Single Supply	P1/626
MC33072	0.50	5.0	10	75	25	4.5	10	$\pm$ 3.0	$\pm$ 44	High Performance	P/626, D/751
MC33072A	500 nA	3.0	10	50	50	4.5	10	$\pm$ 3.0	$\pm$ 44	Single Supply	P/626, D/751
MC33076	0.5	4.0	2.0	70	25	7.4	2.6	$\pm$ 2.0	$\pm$ 18	High Output Current	P1/626, P2/648C, D/751
MC33077	1.0	1.0	2.0	180	150	37	11	$\pm$ 2.5	$\pm$ 18	Low Noise	P/626, D/751
MC33078	750 nA	2.0	2.0	150	31.6	16	7.0	$\pm$ 5.0	$\pm$ 18	Low Noise	N/626, D/751
MC33102 (Awake)	600 nA	3.0	1.0	60	25	4.6	1.7	$\pm$ 2.5	$\pm$ 18	Sleep-Mode™	P/626, D/751
(Sleep)	60 nA	3.0	1.0	6.0	15	0.3	0.1	$\pm$ 2.5	$\pm$ 18	Micropower	P/626, D/751
MC33172	0.10	4.5	10	20	50	1.8	2.1	$\pm$ 3.0	$\pm$ 44	Low Power, Single Supply	P/626, D/751
MC33178	0.5	3.0	2.0	50	50	5.0	2.0	$\pm$ 2.0	$\pm$ 18	High Output Current	P/626, D/751
MC33182	0.1 nA	3.0	10	0.05	25	4.0	10	$\pm$ 2.5	$\pm$ 18	Low Power, JFET Input	P/626, D/751
MC33272A	650 nA	1.0	0.56	25 nA	31.6	5.5	11.5	$\pm$ 1.5	$\pm$ 18	High Performance	P/626, D/751
MC33282	100 pA	200 $\mu$ V	5.0	50 pA	50	30	12	$\pm$ 2.5	$\pm$ 18	Low Input, Offset JFET	P/626, D/751
TL062V	200 pA	6.0	10	100 pA	4.0	2.0	6.0	$\pm$ 2.5	$\pm$ 18	Low Power, JFET Input	P/626, D/751

**Table 2. Dual Operational Amplifiers (continued)**

Device	$I_{IB}$ ( $\mu$ A)	$V_{IO}$ (mV)	$TC_{VIO}$ ( $\mu$ V/ $^{\circ}$ C)	$I_{IO}$ (nA)	$A_{vol}$ (V/mV)	BW ( $A_V = 1$ ) (MHz)	SR ( $A_V = 1$ ) (V/ $\mu$ s)	Supply Voltage (V)		Description	Suffix/ Package
	Max	Max	Typ	Max	Min	Typ	Typ	Min	Max		
<b>Extended Automotive Temperature Range (-40°C to +105°C)</b>											
MC33202 MC33206	250 nA	11	2.0	100	50	2.2	1.0	$\pm 0.9$	$\pm 6.0$	Low V Rail-to-Rail Rail-to-Rail with Enable	P/626, D/751 P/646, D/751A
LM2904	0.25	10	7.0	50	100 typ	1.0	0.6	$\pm 1.5$ $+3.0$	$\pm 13$ $+26$	Split or Single Supply	N/626, D/751
<b>Extended Automotive Temperature Range (-40°C to +125°C)</b>											
TCA0372	500 nA	15	20	50	30	1.1	1.4	$+5.0$	$+36$	Power Op Amp, Single Supply	DP2/648, DW/751G
LM2904V	0.25	13	7.0	50	100 typ	1.0	0.6	$\pm 1.5$ $+3.0$	$\pm 13$ $+26$	Split or Single Supply	N/626, D/751
<b>Military Temperature Range (-55°C to +125°C)</b>											
MC33202	400 pA	11	2.0	200 pA	50	2.2	1.0	$\pm 0.9$	$\pm 6.0$	Low V Rail-to-Rail	P/626, D/751

**Table 3. Quad Operational Amplifiers**

Device	$I_{IB}$ ( $\mu$ A)	$V_{IO}$ (mV)	$TC_{VIO}$ ( $\mu$ V/ $^{\circ}$ C)	$I_{IO}$ (nA)	$A_{vol}$ (V/mV)	BW ( $A_V = 1$ ) (MHz)	SR ( $A_V = 1$ ) (V/ $\mu$ s)	Supply Voltage (V)		Description	Suffix/ Package
	Max	Max	Typ	Max	Min	Typ	Typ	Min	Max		
<b>Internally Compensated</b>											
<b>Commercial Temperature Range (0°C to +70°C)</b>											
LF347	200 pA	10	10	100 pA	25	4.0	13	$\pm 5.0$	$\pm 18$	JFET Input	N/646
LF347B	200 pA	5.0	10	100 pA	50	4.0	13	$\pm 5.0$	$\pm 18$	JFET Input	N/646
LF444C	100 pA	10	10	50 pA	25	2.0	6.0	$\pm 5.0$	$\pm 18$	Low Power, JFET Input	N/646, D/751A
LM324, A	0.25	6.0	7.0	50	25	1.0	0.6	$\pm 1.5$ $+3.0$	$\pm 16$ $+32$	Low Power Consumption	N/646, D/751A
MC3403	0.5	10	7.0	50	20	1.0	0.6	$\pm 1.5$ $+3.0$	$\pm 18$ $+36$	No Crossover Distortion	P/646, D/751A
MC4741C	0.5	6.0	15	200	20	1.0	0.5	$\pm 3.0$	$\pm 18$	Quad MC1741	P/646, D/751A
MC34004	200 pA	10	10	100 pA	25	4.0	13	$\pm 5.0$	$\pm 18$	JFET Input	P/646
MC34004B	200 pA	5.0	10	100 pA	50	4.0	13	$\pm 5.0$	$\pm 18$	JFET Input	P/646
MC34074	0.5	5.0	10	75	25	4.5	10	$+3.0$	$+44$	High Performance	P/646, D/751A
MC34074A	500 nA	3.0	10	50	50	4.5	10	$+3.0$	$+44$	Single Supply	P/646, D/751A
MC34084	200 pA	12	10	100 pA	25	8.0	30	$\pm 5.0$	$\pm 22$	High Speed, JFET Input	P/646, DW/751G
MC34085B	200 pA	12	10	100 pA	25	16	55	$\pm 5.0$	$\pm 22$	Decompensated	P/646, DW/751G
MC34184	0.1 nA	10	10	0.05	25	4.0	10	$\pm 2.5$	$\pm 18$	Low Power, JFET Input	P/646, D/751A
TL064AC	200 pA	6.0	10	100 pA	4.0	2.0	6.0	$\pm 2.5$	$\pm 18$	Low Power, JFET Input	N/646, D/751A
TL064C	200 pA	15	10	200 pA	4.0	2.0	6.0	$\pm 2.5$	$\pm 18$	Low Power, JFET Input	N/646, D/751A
TL074AC	200 pA	6.0	10	50 pA	50	4.0	13	$\pm 5.0$	$\pm 18$	Low Noise, JFET Input	N/646
TL074C	200 pA	10	10	50 pA	25	4.0	13	$\pm 5.0$	$\pm 18$	Low Noise, JFET Input	N/646
TL084AC	200 pA	6.0	10	100 pA	50	4.0	13	$\pm 5.0$	$\pm 18$	JFET Input	N/646
TL084C	400 pA	15	10	200 pA	25	4.0	13	$\pm 5.0$	$\pm 18$	JFET Input	N/646
<b>Industrial Temperature Range (-25°C to +85°C)</b>											
LM224, A	0.15	5.0	7.0	30	50	1.0	0.6	$\pm 1.5$ $+3.0$	$\pm 16$ $+32$	Split Supplies or Single Supply	N/646, D/751A
<b>Automotive Temperature Range (-40°C to +85°C)</b>											
MC3303	0.5	8.0	10	75	20	1.0	0.6	$\pm 1.5$ $+3.0$	$\pm 18$ $+36$	Differential General Purpose	P/646, D/751A
MC33074	0.5	4.5	10	75	25	4.5	10	$+3.0$	$+44$	High Performance, Single Supply	P/646, D/751A
MC33074A	500 nA	3.0	10	50	50	4.5	10	$+3.0$	$+44$	High Performance	P/646, D/751A
MC33079	750 nA	2.5	2.0	150	31.6	9.0	7.0	$\pm 5.0$	$\pm 18$	Low Noise	N/646, D/751A



**Table 3. Quad Operational Amplifiers (continued)**

Device	I <sub>B</sub> (μA) Max	V <sub>IO</sub> (mV) Max	TC <sub>VIO</sub> (μV/°C) Typ	I <sub>O</sub> (nA) Max	A <sub>vol</sub> (V/mV) Min	BW (A <sub>V</sub> = 1) (MHz) Typ	SR (A <sub>V</sub> = 1) (V/μs) Typ	Supply Voltage (V)		Description	Suffix/ Package
								Min	Max		
MC33174	0.1	4.5	10	20	50	1.8	2.1	+3.0	+44	Low Power, Single Supply	P/646, D/751A
MC33179	0.5	3.0	2.0	50	50	5.0	2.0	±2.0	±18	High Output Current	P/646, D/751A
MC33184	0.1 nA	10	10	0.05	25	4.0	10	±2.5	±18	Low Power, JFET Input	P/646, D/751A
MC33274A	650 nA	1.0	0.56	25 nA	31.6	5.5	11.5	±1.5	±18	High Performance	P/646, D/751A
MC33284	100 pA	2.0	5.0	50 pA	50	30	12	±2.5	±18	Low Input, Offset JFET	P/646, D/751A
TL064V	200 pA	9.0	10	100 pA	4.0	2.0	6.0	±2.5	±18	Low Power, JFET Input	N/646, D/751A
<b>Extended Automotive Temperature Range (–40°C to +105°C)</b>											
MC33204	250 nA	13	2.0	100	50	2.2	1.0	±0.9	±6.0	Low V Rail-to–Rail	P/646, D/751A
MC33207					50	2.2		±0.9	±6.0		
MC33304					25	3.0		+1.8	+12		
LM2902	0.5	10	–	50	15	1.0	0.6	±1.5	±13	Differential Low Power	N/646, D/751A
<b>Extended Automotive Temperature Range (–40°C to +125°C)</b>											
LM2902V	0.5	13	–	50	15	1.0	0.6	±1.5	±13	Differential Low Power	N/646, D/751A
<b>Military Temperature Range (–55°C to +125°C)</b>											
MC33204	400 pA	13	2.0	200 pA	50	2.2	1.0	±0.9	±6.0	Low V Rail-to–Rail	P/646, D/751A

## High Frequency Amplifiers

A variety of high frequency circuits with features ranging from low cost simplicity to multifunction versatility marks Motorola's line of integrated amplifiers. Devices described here are intended for industrial and communications applications. For devices especially dedicated to consumer products, i.e., TV and entertainment radio. (See the Consumer Electronics Circuits section.)

### AGC Amplifiers

#### MC1490/MC1350 Family Wideband General Purpose Amplifiers

The MC1490 and MC1350 family are basic building blocks – AGC (Automatic Gain Controlled) RF/Video

Amplifiers. These parts are recommended for applications up through 70 MHz. The best high frequency performance may be obtained by using the physically smaller SOIC version (shorter leads) – MC1350D. There are currently no other RF ICs like these, because other manufacturers have dropped their copies. Applications include variable gain video and instrumentation amplifiers, IF (Intermediate Frequency) amplifiers for radio and TV receivers, and transmitter power output control. Many uses will be found in medical instrumentation, remote monitoring, video/graphics processing, and a variety of communications equipment. The family of parts using the same basic die (identical circuit with slightly different test parameters) is listed in the following table.

**Table 4. High Frequency Amplifier Specifications**

Operating Temperature Range		A <sub>v</sub> (dB)	Bandwidth @ MHz	V <sub>CC</sub> /V <sub>EE</sub> (Vdc)		Suffix/ Package
–40° to +85°C	0° to +70°C			Minimum	Maximum	
–	MC1350	50	45	+6.0	+18	P/626, D/751
MC1490	–	50 45 35	10 60 100			P/626

# Miscellaneous Amplifiers

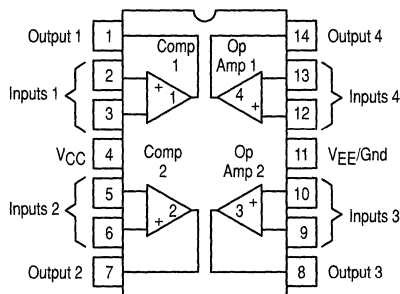
Motorola provides several Bipolar and CMOS special purpose amplifiers which fill specific needs. These devices

range from low power CMOS programmable amplifiers and comparators to variable-gain bipolar power amplifiers.

## MC3405

### Dual Operational Amplifier and Dual Voltage Comparator

This device contains two Differential Input Operational Amplifiers and two Comparators; each set capable of single supply operation. This operational amplifier-comparator circuit will find its applications as a general purpose product for automotive circuits and as an industrial "building block."



**Table 5. Bipolar**

Device	$I_{IB}$ ( $\mu A$ ) Max	$V_{IO}$ (mV) Max	$I_{IO}$ (nA) Max	$A_{vol}$ (V/mV) Min	Response ( $\mu s$ ) Typ	Supply Voltage		Suffix/ Package
						Single	Dual	
MC3405	0.5	10	50	20	1.3	3.0 to 36	$\pm 1.5$ to $\pm 18$	P/646

## MC14573

### Quad Programmable Operational Amplifier

## MC14575

### Dual Programmable Operational Amplifier and Dual Programmable Comparator

## MC14576C/MC14577C

### Dual Video Amplifiers

**Table 6. CMOS**

Function	Quantity Per Package	Single Supply Voltage Range	Dual Supply Voltage Range	Frequency Range	Device	Suffix/ Package
Operational Amplifiers	4	3.0 to 15 V	$\pm 1.5$ to $\pm 7.5$ V	DC to 1.0 MHz	MC14573	P/648, D/751B
Operational Amplifiers and Comparators	2 and 2	3.0 to 15 V	$\pm 1.5$ to $\pm 7.5$ V	DC to 1.0 MHz	MC14575	P/648, D/751B
Video Amplifiers	2	5.0 to 12 V <sup>(1)</sup>	$\pm 2.5$ to $\pm 6.0$ V <sup>(2)</sup>	Up to 10 MHz	MC14576C MC14577C	P/626, F/904

(1) 5.0 to 10 V for surface mount package.

(2)  $\pm 2.5$  to  $\pm 5.0$  V for surface mount package.

# Comparators

**Table 7. Single Comparators**

Device	I <sub>B</sub> ( $\mu$ A) Max	V <sub>IO</sub> (mV) Max	I <sub>O</sub> ( $\mu$ A) Max	A <sub>v</sub> (V/V) Typ	I <sub>O</sub> (mA) Min	Response Time (ns)	Supply Voltage (V)	Description	Temperature Range (°C)	Suffix/ Package
<b>Bipolar</b>										
LM211	0.1	3.0	0.01	200 k	8.0	200	+15, -15	With strobe, will operate from single supply	-25 to +85 0 to +70	D/751 N/626, D/751
LM311	0.25	7.5	0.05							
<b>CMOS</b>										
MC14578	1.0 pA	50	-	-	1.1	-	3.5 to 14	Requires only 10 $\mu$ A from single-ended supply	-30 to +70	P/648, D/751B

**Table 8. Dual Comparators**

Device	I <sub>B</sub> ( $\mu$ A) Max	V <sub>IO</sub> (mV) Max	I <sub>O</sub> ( $\mu$ A) Max	A <sub>v</sub> (V/V) Typ	I <sub>O</sub> (mA) Min	Response Time (ns)	Supply Voltage (V)	Description	Temperature Range (°C)	Suffix/ Package
<b>Bipolar</b>										
LM393	0.25	5.0	0.05	200 k	6.0	1300	$\pm$ 1.5 to $\pm$ 18 or 3.0 to 36	Designed for single or split supply operation, input common mode includes ground (negative supply)	0 to +70 0 to +70 -40 to +105 -40 to +125	N/626, D/751
LM393A		2.0								
LM2903		7.0								
LM2903V		7.0								
MC3405	0.5	10	0.05	200 k	6.0	1300	$\pm$ 1.5 to $\pm$ 7.5 or 3.0 to 15	This device contains 2 op amps and 2 comparators in a single package	0 to +70	P/646
<b>CMOS</b>										
MC14575	0.001	30	0.0001	2.0 k	3.0	1000	$\pm$ 1.5 to $\pm$ 7.5 or 3.0 to 15	This device contains 2 op amps and 2 comparators in a single package	-40 to +85	P/648, D/751B

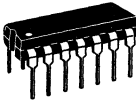
**Table 9. Quad Comparators**

Device	I <sub>B</sub> ( $\mu$ A) Max	V <sub>IO</sub> (mV) Max	I <sub>O</sub> ( $\mu$ A) Max	A <sub>v</sub> (V/V) Typ	I <sub>O</sub> (mA) Min	Response Time (ns)	Supply Voltage (V)	Description	Temperature Range (°C)	Suffix/ Package
<b>Bipolar</b>										
LM239	0.25	5.0	0.05	200 k	6.0	1300	$\pm$ 1.5 to $\pm$ 18 or 3.0 to 36	Designed for single or split supply operation, input common mode includes ground (negative supply)	-25 to +85 -25 to +85 0 to +70 0 to +70 -40 to +85 -40 to +125 -40 to +85	N/646, D/751A
LM239A		2.0								
LM339		5.0								
LM339A		2.0								
LM2901		7.0								
LM2901V		7.0								
MC3302		0.5		20						
<b>CMOS</b>										
MC14574	0.001	30	0.0001	2.0 k	3.0	1000	$\pm$ 1.5 to $\pm$ 7.5 or 3.0 to 15	Externally programmable power dissipation with 1 or 2 resistors	-40 to +85	P/648, D/751B

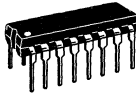
# Amplifiers and Comparators Package Overview



**CASE 626**  
N, P, P1 SUFFIX



**CASE 646**  
N, P SUFFIX



**CASE 648, 648C**  
DP2, P, P2 SUFFIX



**CASE 751**  
D SUFFIX



**CASE 751A**  
D SUFFIX



**CASE 751B**  
D SUFFIX



**CASE 751G**  
DW SUFFIX



**CASE 904**  
F SUFFIX

# Power Supply Circuits

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## In Brief . . .

In most electronic systems, some form of voltage regulation is required. In the past, the task of voltage regulator design was tediously accomplished with discrete devices, and the results were quite often complex and costly. Today, with bipolar monolithic regulators, this task has been significantly simplified. The designer now has a wide choice of fixed, low  $V_{Dif}$  and adjustable type voltage regulators. These devices incorporate many built-in protection features, making them virtually immune to the catastrophic failures encountered in older discrete designs.

The switching power supply continues to increase in popularity and is one of the fastest growing markets in the world of power conversion. They offer the designer several important advantages over linear series-pass regulators. These advantages include significant advancements in the areas of size and weight reduction, improved efficiency, and the ability to perform voltage step-up, step-down, and voltage-inverting functions. Motorola offers a diverse portfolio of full featured switching regulator control circuits which meet the needs of today's modern compact electronic equipment.

Power supplies, MPU/MCU-based systems, industrial controls, computer systems and many other product applications are requiring power supervisory functions which monitor voltages to ensure proper system operation. Motorola offers a wide range of power supervisory circuits that fulfill these needs in a cost effective and efficient manner. MOSFET drivers are also provided to enhance the drive capabilities of first generation switching regulators or systems designed with CMOS/TTL logic devices. These drivers can also be used in dc-to-dc converters, motor controllers or virtually any other application requiring high speed operation of power MOSFETs.

	<b>Page</b>
Linear Voltage Regulators . . . . .	4.2-2
Fixed Output . . . . .	4.2-2
Adjustable Output . . . . .	4.2-4
Micropower Voltage Regulators for Portable Applications . . . . .	4.2-5
80 mA Micropower Voltage Regulator . . . . .	4.2-5
120 mA Micropower Voltage Regulator . . . . .	4.2-6
Micropower Voltage Regulator for	
External Power Transistor . . . . .	4.2-6
Micropower Voltage Regulators with On/Off Control . . . . .	4.2-7
Special Regulators . . . . .	4.2-8
Voltage Regulator/Supervisory . . . . .	4.2-8
SCSI Regulator . . . . .	4.2-11
Switching Regulator Control Circuits . . . . .	4.2-12
Single-Ended . . . . .	4.2-12
Single-Ended with On-Chip Power Switch . . . . .	4.2-14
Easy Switcher™ Single-Ended Controllers with	
On-Chip Power Switch . . . . .	4.2-14
Very High Voltage Single-Ended with	
On-Chip Power Switch . . . . .	4.2-15
Double-Ended . . . . .	4.2-15
CMOS Micropower DC-to-DC Converters . . . . .	4.2-17
Single-Ended GreenLine™ Controllers . . . . .	4.2-18
Very High Voltage Switching Regulator . . . . .	4.2-20
Special Switching Regulator Controllers . . . . .	4.2-23
Dual Channel . . . . .	4.2-23
Universal Microprocessor . . . . .	4.2-23
Power Factor . . . . .	4.2-24
Supervisory Circuits . . . . .	4.2-27
Overvoltage Crowbar Sensing . . . . .	4.2-27
Over/Undervoltage Protection . . . . .	4.2-27
CMOS Micropower Undervoltage Sensing . . . . .	4.2-28
CMOS Micropower Undervoltage Sensing with	
Output Delay . . . . .	4.2-29
Undervoltage Sensing . . . . .	4.2-30
Universal Voltage Monitor . . . . .	4.2-31
Battery Management Circuits . . . . .	4.2-32
Battery Charger ICs . . . . .	4.2-32
Battery Pack ICs . . . . .	4.2-34
MOSFET/IGBT Drivers . . . . .	4.2-38
High Speed Dual Drivers . . . . .	4.2-38
Single IGBT Driver . . . . .	4.2-38
Package Overview . . . . .	4.2-40

# Linear Voltage Regulators

## Fixed Output

These low cost monolithic circuits provide positive and/or negative regulation at currents from 100 mA to 3.0 A. They are ideal for on-card regulation employing current limiting and thermal shutdown. Low  $V_{D\text{iff}}$  devices are offered for battery powered systems.

Although designed primarily as fixed voltage regulators, these devices can be used with external components to obtain adjustable voltages and currents.

**Table 1. Linear Voltage Regulators**

Device	$V_{\text{out}}$	25°C Tol. ±%	$V_{\text{in}}$ Max	$V_{\text{in}}-V_{\text{out}}$ Diff. Typ.	Regline Max (% $V_{\text{out}}$ )	Regload Max (% $V_{\text{out}}$ )	Typ. Temp. Coefficient mV ( $V_{\text{out}}$ ) °C	Suffix/Package
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### Fixed Voltage, 3-Terminal Regulators, 0.1 Amperes

LM2931*/A-5.0*	5.0	5.0/3.8	40	0.16	0.6	1.0	0.2	D/751, D2T/936, DT, DT-1, T/221A, Z
LP2950C*/AC*	3.0	0.5	30	0.38	0.2/0.1	0.2/0.1	0.04	DT-3.0, Z-3.0
	3.3							DT-3.3, Z-3.3
	5.0							DT-5.0, Z-5.0
MC78LXXC/AC/AB*	5.0, 8.0, 9.0	8.0/4.0	30	1.7	4.0/3.0	1.2	0.2	D/751, P/29
MC78LXXC/AC/AB*	12, 15, 18	8.0/4.0	35	1.7	2.0	1.0	0.2	D/751, P/29
MC78L24C/AC/AB*	24	8.0/4.0	40	1.7	2.0	1.0	0.2	D/751, P/29
MC79L05C/AC/AB*	-5.0	8.0/4.0	30	1.7	4.0/3.0	1.2	0.2	D/751, P/29
MC79LXXC/AC/AB*	-(12, 15, 18)	8.0/4.0	35	1.7	2.0	1.0	0.2	D/751, P/29
MC79L24C/AC/AB*	-24	8.0/4.0	40	1.7	2.0	1.0	0.2	D/751, P/29
MC33160**	5.0	5.0	40	2.0	0.8	1.0	-	P/626

### Fixed Voltage, 3-Terminal Regulators, 0.5 Amperes

MC78MXXB*/C	5.0, 6.0, 8.0, 12	4.0	35	2.0	1.0	2.0	±0.04	DT, DT-1, T/221A
MC78MXXB*/C	15, 18	4.0	35	2.0	1.0	2.0	±0.04	DT, DT-1, T/221A
MC78MXXB*/C	20, 24	4.0	40	2.0	0.25	2.0	±0.04	DT, DT-1, T/221A
MC79MXXB*/C	-(5.0, 8.0, 12, 15)	4.0	35	1.1	1.0	2.0	-0.07 to ±0.04	DT, DT-1, T/221A
MC33267*	5.05	2.0	40	0.58	1.0	1.0	-	D2T/936A, T/314D, TV

### Fixed Voltage, 3-Terminal Medium Dropout Regulators, 0.8 Amperes

MC33269-XX*	3.3, 5.0, 12	1.0	20	1.0	0.3	1.0	-	D/751, DT, T/221A
MC34268	2.85	1.0	15	0.95	0.3	1.0	-	D/751, DT

Unless otherwise noted,  $T_J = 0^\circ$  to  $+125^\circ\text{C}$

\*  $T_J = -40^\circ$  to  $+125^\circ\text{C}$

\*\*  $T_A = -40^\circ$  to  $+85^\circ\text{C}$

**Table 1. Linear Voltage Regulators (continued)**

Device	V <sub>out</sub>	25°C Tol. ±%	V <sub>in</sub> Max	V <sub>in</sub> -V <sub>out</sub> Diff. Typ.	Regline Max (% V <sub>out</sub> )	Regload Max (% V <sub>out</sub> )	Typ. Temp. Coefficient mV (V <sub>out</sub> ) °C	Suffix/Package
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**Fixed Voltage, 3-Terminal Regulators, 1.0 Amperes**

MC78XXB*/C/AC	5.0, 6.0, 8.0, 12, 18	4.0/2.0	35	2.0	2.0/1.0	2.0	-0.06 to -0.22	D2T/936, T/221A
MC7824B*/C/AC	24	4.0/2.0	40	2.0	2.0/1.0	2.0/0.4	0.125	D2T/936, T/221A
MC79XXC/AC	-(5.0, 5.2, 6.0)	4.0/2.0	35	2.0	2.0/1.0	2.0	-0.2	D2T/936, T/221A
MC79XXC/AC	-(8.0, 12, 15, 18)	4.0/2.0	35	2.0	2.0/1.0	2.0/1.25	-0.12 to -0.06	D2T/936, T/221A
MC7924C	-24	4.0	40	2.0	1.0	2.0	-0.04	D2T/936, T/221A
LM340/A-XX	5.0, 6.0, 12, 15, 18	4.0/2.0	35	1.7	1.0/0.2	1.0/0.5	±0.12	T/221A
LM340-24	24	4.0	40	1.7	1.0	1.0	±0.12	T/221S
TL780-XXC	5.0, 12, 15	1.0	35	2.0	0.10	0.5	0.012	KC

**Fixed Voltage, 3-Terminal Regulators, 3.0 Amperes**

MC78TXXC/AC	5.0, 8.0, 12	4.0/2.0	35	2.5	0.5	0.6	0.04	T/221A
MC78T15C/AC	15	4.0/2.0	40	2.5	0.5	0.6	0.04	T/221A
LM323/A	5.0	4.0/2.0	20	2.3	0.5/0.3	2.0/1.0	±0.2	T/221A

 Unless otherwise noted, T<sub>J</sub> = 0° to +125°C

 \* T<sub>J</sub> = -40° to +125°C

 \*\* T<sub>A</sub> = -40° to +85°C

**Table 2. Fixed Voltage Medium and Low Dropout Regulators**

Device	V <sub>out</sub>	25°C Tol. ±%	I <sub>O</sub> (mA) Max	V <sub>in</sub> Max	V <sub>in</sub> -V <sub>out</sub> Diff. Typ.	Regline Max (% V <sub>out</sub> )	Regload Max (% V <sub>out</sub> )	Typ. Temp. Coefficient mV (V <sub>out</sub> ) °C	Suffix/Package
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**Fixed Voltage, Medium Dropout Regulators**

MC33267*	5.05	2.0	500	40	0.58	1.0	1.0	-	D2T/936A, T/314D, TV
MC34268	2.85	1.0	800	15	0.95	0.3	1.0		D/751, DT
MC33269-XX*	3.3, 5.0, 12			20	1.0				D/751, DT, T/221A

**Fixed Voltage, Low Dropout Regulators**

LM2931*/A*	5.0	5.0/3.8	100	37	0.16	1.12	1.0	±2.5	D/751, D2T/936A, DT, DT-1, T/221A, Z
LP2950C*/AC*	3.0	1.0/0.5	100	30	0.38	0.2/0.1	0.2/0.1	0.2	DT-3.0, Z-3.0
	3.3								DT-3.3, Z-3.3
	5.0								DT-5.0, Z-5.0

 Unless otherwise noted, T<sub>J</sub> = 0° to +125°C

 \* T<sub>J</sub> = -40° to +125°C

**Table 2. Fixed Voltage Medium and Low Dropout Regulators (continued)**

Device	V <sub>out</sub>	25°C Tol. ±%	I <sub>O</sub> (mA) Max	V <sub>in</sub> Max	V <sub>in</sub> -V <sub>out</sub> Diff. Typ.	Regline Max (% V <sub>out</sub> )	Regload Max (% V <sub>out</sub> )	Typ. Temp. Coefficient mV (V <sub>out</sub> )/°C	Suffix/Package
<b>Fixed Voltage, Low Dropout Regulators</b>									
LP2951C*/AC*	3.0	1.0/0.5	100	28.75	0.38	0.04/0.02	0.04/0.02	±1.0	D-3.0/751, DM-3.0/846A, N-3.0/626
	3.3								D-3.3/751, DM-3.3/846A, N-3.3/626
	5.0								D/751, DM/846A, N/626
LM2935*	5.0/5.0	5.0/5.0	500/10	60	0.45/0.55	1.0	1.0	-	D2T/936A, T/314D, TH, TV

Unless otherwise noted, T<sub>J</sub> = 0° to +125°C

\* T<sub>J</sub> = -40° to +125°C

## Adjustable Output

Motorola offers a broad line of adjustable output voltage regulators with a variety of output current capabilities. Adjustable voltage regulators provide users the capability of stocking a single integrated circuit offering a wide range of

output voltages for industrial and communications applications. The three-terminal devices require only two external resistors to set the output voltage.

**Table 3. Adjustable Output Regulators**

Device	V <sub>out</sub>	I <sub>O</sub> (mA) Max	V <sub>in</sub> Max	V <sub>in</sub> -V <sub>out</sub> Diff. Typ.	Regline Max (% V <sub>out</sub> )	Regload Max (% V <sub>out</sub> )	Typ. Temp. Coefficient mV (V <sub>out</sub> )/°C	Suffix/Package
<b>Adjustable Regulators</b>								
LM317L/B*	2.0-37	100	40	1.9	0.07	1.5	±0.35	D/751, Z
LM2931C*	3.0-24	100	37	0.16	1.12	1.0	±2.5	D/751, D2T/936A, T/314D, TH, TV
LP2951C*/AC*	1.25-29	100	28.75	0.38	0.04/0.02	0.04/0.02	±1.0	D-3.0/751, DM-3.0/846A, N-3.0/626
								D-3.3/751, DM-3.3/846A, N-3.3/626
								D/751, DM/846A, N/626

Unless otherwise noted, T<sub>J</sub> = 0° to +125°C

\* T<sub>J</sub> = -40° to +125°C

# T<sub>A</sub> = 0° to +70°C



**Table 3. Adjustable Output Regulators (continued)**

Device	V <sub>out</sub>	I <sub>O</sub> (mA) Max	V <sub>in</sub> Max	V <sub>in</sub> -V <sub>out</sub> Diff. Typ.	Regline Max (% V <sub>out</sub> )	Regload Max (% V <sub>out</sub> )	Typ. Temp. Coefficient mV (V <sub>out</sub> ) °C	Suffix/ Package
<b>Adjustable Regulators</b>								
MC1723C#	2.0-37	150	38	2.5	0.5	0.2	±0.033	D/751, P/646
LM317M/B*	1.2-37	500	40	2.1	0.04	0.5	±0.35	DT, DT-1, T/221A
LM337M/B*	-(1.2-37)	500	40	1.9	0.07	1.5	±0.3	T/221A
MC33269*	1.25-19	800	18.75	1.0	0.3	0.5	±0.4	D/751, DT, T/221A
LM317/B*	1.2-37	1500	40	2.25	0.07	1.5	±0.35	D2T/936, T/221A
LM337/B*	-(1.2-37)	1500	40	2.3	0.07	1.5	±0.3	D2T/936, T/221A
LM350/B*	1.2-33	3000	35	2.7	0.07	1.5	±0.5	T/221A

Unless otherwise noted, T<sub>J</sub> = 0° to +125°C

\* T<sub>J</sub> = -40° to +125°C

# T<sub>A</sub> = 0° to +70°C

## Micropower Voltage Regulators for Portable Applications

### 80 mA Micropower Voltage Regulator

#### MC78LC00H, N

T<sub>A</sub> = -30° to +80°C, Case 1213, 1212

The MC78LC00 series voltage regulators are specifically designed for use as a power source for video instruments, handheld communication equipment, and battery powered equipment.

The MC78LC00 series features an ultra-low quiescent of 1.1 µA and a high accuracy output voltage. Each device contains a voltage reference, an error amplifier, a driver transistor and resistors for setting the output voltage. These devices are available in either SOT-89, 3 pin, or SOT-23, 5 pin, surface mount packages.

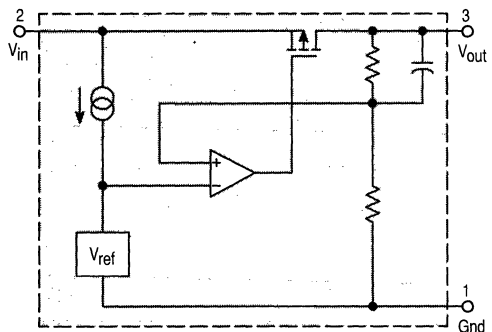
#### MC78LC00 Series Features:

- Low Quiescent Current of 1.1 µA Typical
- Low Dropout Voltage (30 mV Typical)
- Excellent Line Regulation (0.1%)
- High Accuracy Output Voltage (±2.5%)
- Wide Output Voltage Range (2.0 V to 6.0 V)
- Output Current for Low Power (80 mA Typical)
- Two Surface Mount Packages (SOT-89, 3 Pin, or SOT-23, 5 Pin)

#### ORDERING INFORMATION

Device	Output Voltage	Operating Temperature Range	Package
MC78LC30HT1	3.0	T <sub>A</sub> = -30° to +80°C	SOT-89
MC78LC33HT1	3.3		
MC78LC40HT1	4.0		
MC78LC50HT1	5.0		
MC78LC30NTR	3.0	SOT-23	
MC78LC33NTR	3.3		
MC78LC40NTR	4.0		
MC78LC50NTR	5.0		

Other voltages from 2.0 to 6.0 V, in 0.1 V increments, are available upon request. Consult your local Motorola sales office for information.



## Micropower Voltage Regulators for Portable Applications (continued)

### 120 mA Micropower Voltage Regulator

#### MC78FC00H

$T_A = -30^\circ$  to  $+80^\circ\text{C}$ , Case 1213

The MC78FC00 series voltage regulators are specifically designed for use as a power source for video instruments, handheld communication equipment, and battery powered equipment.

The MC78FC00 series voltage regulator ICs feature a high accuracy output voltage and ultra-low quiescent current. Each device contains a voltage reference unit, an error amplifier, a driver transistor, and resistors for setting output voltage, and a current limit circuit. These devices are available in SOT-89 surface mount packages, and allow construction of an efficient, constant voltage power supply circuit.

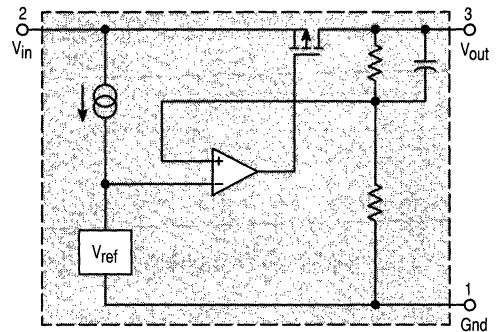
#### MC78FC00 Series Features:

- Ultra-Low Quiescent Current of 1.1  $\mu\text{A}$  Typical
- Ultra-Low Dropout Voltage (0.5 V Typical)
- Large Output Current (120 mA Typical)
- Excellent Line Regulation (0.1%)
- Wide Operating Voltage Range (2.0 V to 10 V)
- High Accuracy Output Voltage ( $\pm 2.5\%$ )
- Wide Output Voltage Range (2.0 V to 6.0 V)
- Surface Mount Package (SOT-89)

#### ORDERING INFORMATION

Device	Output Voltage	Operating Temperature Range	Package
MC78FC30HT1	3.0	$T_A = -30^\circ$ to $+80^\circ\text{C}$	SOT-89
MC78FC33HT1	3.3		
MC78FC40HT1	4.0		
MC78FC50HT1	5.0		

Other voltages from 2.0 to 6.0 V, in 0.1 V increments, are available upon request. Consult your local Motorola sales office for information.



### Micropower Voltage Regulator for External Power Transistor

#### MC78BC00N

$T_A = -30^\circ$  to  $+80^\circ\text{C}$ , Case 1212

The MC78BC00 voltage regulators are specifically designed to be used with an external power transistor to deliver high current with high voltage accuracy and low quiescent current.

The MC78BC00 series are devices suitable for constructing regulators with ultra-low dropout voltage and output current in the range of several tens of mA to hundreds of mA. These devices have a chip enable function, which minimizes the standby mode current drain. Each of these devices contains a voltage reference unit, an error amplifier, a driver transistor and resistors. These devices are available in the SOT-23, 5 pin surface mount packages.

These devices are ideally suited for battery powered equipment, and power sources for hand-held audio instruments, communication equipment and domestic appliances.

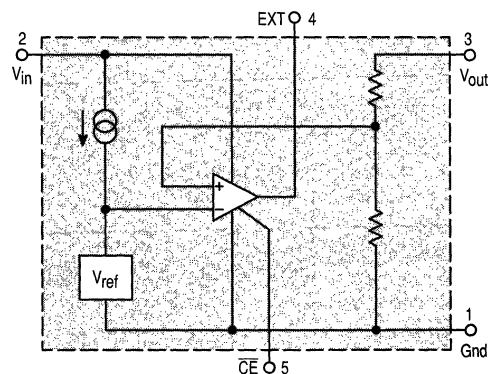
#### MC78BC00 Series Features:

- Ultra-Low Supply Current (50  $\mu\text{A}$ )
- Standby Mode (0.2  $\mu\text{A}$ )
- Ultra-Low Dropout Voltage (0.1 V with External Transistor and  $I_O = 100$  mA)
- Excellent Line Regulation (Typically 0.1%/V)
- High Accuracy Output Voltage ( $\pm 2.5\%$ )

#### ORDERING INFORMATION

Device	Output Voltage	Operating Temperature Range	Package
MC78BC30NTR	3.0	$T_A = -30^\circ$ to $+80^\circ\text{C}$	SOT-23
MC78BC33NTR	3.3		
MC78BC40NTR	4.0		
MC78BC50NTR	5.0		

Other voltages from 2.0 to 6.0 V, in 0.1 V increments, are available upon request. Consult your local Motorola sales office for information.



## Micropower Voltage Regulators for Portable Applications (continued)

### Micropower Voltage Regulators with On/Off Control

#### MC33264D, DM

$T_A = -40^\circ$  to  $+85^\circ\text{C}$ , Case 751, 846A

The MC33264 series are micropower low dropout voltage regulators available in SO-8 and Micro-8 surface mount packages and a wide range of output voltages. These devices feature a very low quiescent current (100  $\mu\text{A}$  in the ON mode; 0.1  $\mu\text{A}$  in the OFF mode), and are capable of supplying output currents up to 100 mA. Internal current and thermal limiting protection is provided.

Additionally, the MC33264 has either active HIGH or active LOW control (Pins 2 and 3) that allows a logic level signal to turn-off or turn-on the regulator output.

Due to the low input-to-output voltage differential and bias current specifications, these devices are ideally suited for battery powered computer, consumer, and industrial equipment where an extension of useful battery life is desirable.

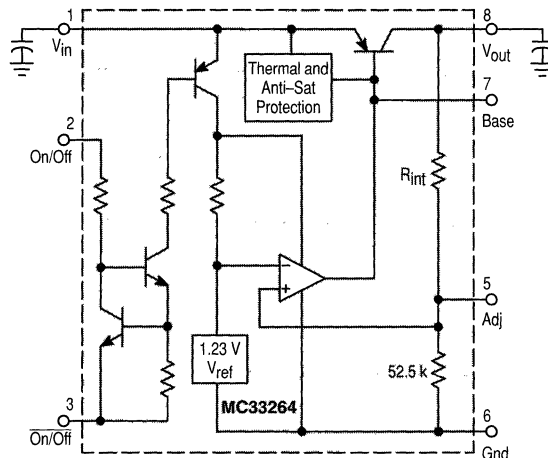
#### MC33264 Features:

- Low Quiescent Current (0.3  $\mu\text{A}$  in OFF Mode; 95  $\mu\text{A}$  in ON Mode)
- Low Input-to-Output Voltage Differential of 47 mV at 10 mA, and 131 mV at 50 mA
- Multiple Output Voltages Available
- Extremely Tight Line and Load Regulation
- Stable with Output Capacitance of Only 0.33  $\mu\text{F}$  for 5.0 V, 6.0 V and 4.75 V Output Voltages  
0.22  $\mu\text{F}$  for 2.8 V, 3.0 V and 3.3 V Output Voltages

- Internal Current and Thermal Limiting
- Logic Level ON/OFF Control
- Functionally Equivalent to TK115XXMC and LP2980

#### ORDERING INFORMATION

Device	Operating Temperature Range	Package
MC33264D-2.8 MC33264D-3.0 MC33264D-3.3 MC33264D-3.8 MC33264D-4.0 MC33264D-4.75 MC33264D-5.0	$T_A = -40^\circ$ to $+85^\circ\text{C}$	SO-8
MC33264DM-2.8 MC33264DM-3.0 MC33264DM-3.3 MC33264DM-3.8 MC33264DM-4.0 MC33264DM-4.75 MC33264DM-5.0		Micro-8



# Special Regulators

## Voltage Regulator/Supervisory

**Table 4. Voltage Regulator/Supervisory**

Device	V <sub>out</sub> (V)		I <sub>o</sub> (mA) Max	V <sub>in</sub> (V)		Regline (mV) Max	Regload (mV) Max	T <sub>A</sub> (°C)	Suffix/Package
	Min	Max		Min	Max				
MC33128*	2.9	3.1	35	3.2	7.0	n/a	30	-30 to +60	D/751B
	2.9	3.1	60				40		
	2.9	3.1	20				25		
	-2.65	-2.35	1.0				20		
MC34160	4.75	5.25	100	7.0	40	40	50	0 to +70	P/648C, DW/751G
MC33160								-40 to +85	
MC33267	4.9	5.2	500	6.0	26	50	50	-40 to +105	T/314D, TH, TV
MC33169*	4.7	6.4	-	2.7	9.5	-	-	-40 to +85	DTB/948G
	6.4	7.0							
	-2.35	-2.65							

\* These ICs are intended for powering cellular phone GaAs power amplifiers and can be used for other portable applications as well.

## Voltage Regulator/Supervisory (continued)

### Microprocessor Voltage Regulator and Supervisory Circuit

#### MC34160P, DW

$T_A = 0^\circ$  to  $+70^\circ\text{C}$ , Case 648C, 751G

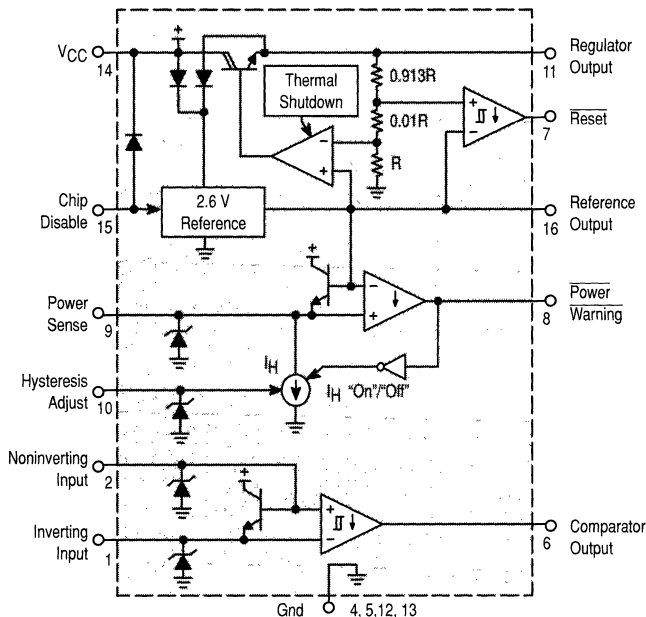
#### MC33160P, DW

$T_A = -40^\circ$  to  $+85^\circ\text{C}$ , Case 648C, 751G

The MC34160 series is a voltage regulator and supervisory circuit containing many of the necessary monitoring functions required in microprocessor based systems. It is specifically designed for appliance and industrial applications offering the designer a cost effective solution with minimal external components. These integrated circuits feature a 5.0 V, 100 mA regulator with short circuit current limiting, pinned out 2.6 V bandgap reference, low voltage reset comparator, power warning comparator with programmable hysteresis, and an uncommitted comparator ideally suited for microprocessor line synchronization.

Additional features include a chip disable input for low standby current, and internal thermal shutdown for over temperature protection.

These devices are contained in a 16 pin dual-in-line heat tab plastic package for improved thermal conduction.



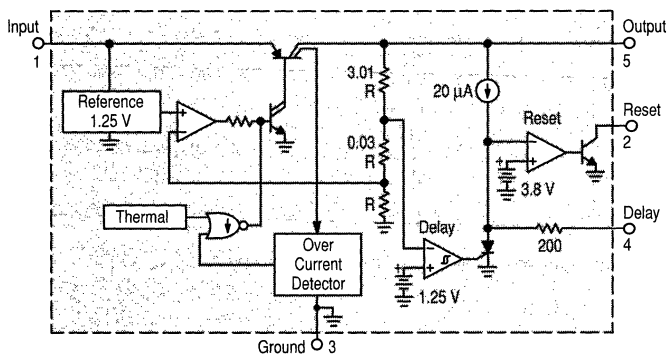
### Low Dropout Regulator

#### MC33267T, TV

$T_J = -40^\circ$  to  $+105^\circ\text{C}$ , Case 314D, 314B

The MC33267 is a positive fixed 5.0 V regulator that is specifically designed to maintain proper voltage regulation with an extremely low input-to-output voltage differential. This device is capable of supplying output currents in excess of 500 mA and contains internal current limiting and thermal shutdown protection. Also featured is an on-chip power-up reset circuit that is ideally suited for use in microprocessor based systems. Whenever the regulator output voltage is below nominal, the reset output is held low. A programmable time delay is initiated after the regulator has reached its nominal level and upon timeout, the reset output is released.

Due to the low dropout voltage specifications, the MC33267 is ideally suited for use in battery powered industrial and consumer equipment where an extension of useful battery life is desirable. This device is contained in an economical five lead TO-220 type package.



## Voltage Regulator/Supervisory (continued)

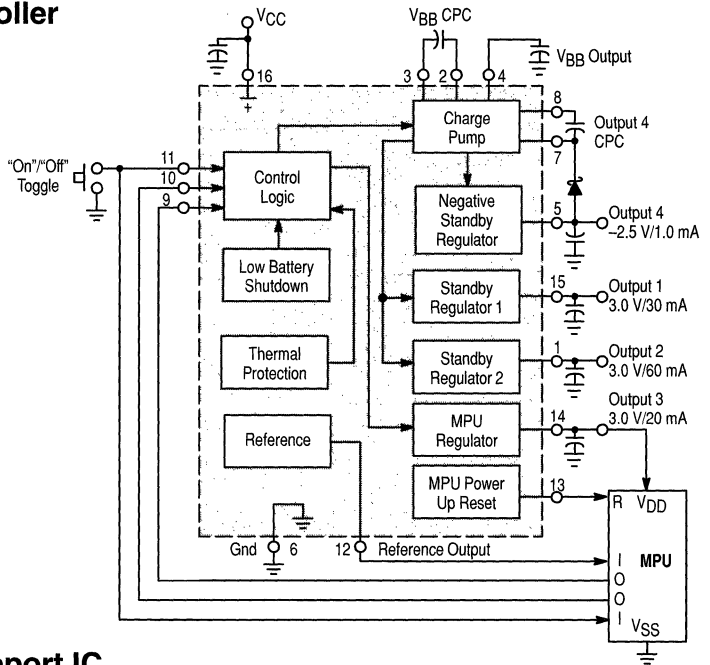
### Power Management Controller

#### MC33128D

$T_A = -30^\circ$  to  $+60^\circ\text{C}$ , Case 751B

The MC33128 is a power management controller specifically designed for use in battery powered cellular telephone and pager applications. This device contains all of the active functions required to interface the user to the system electronics via a microprocessor. This integrated circuit consists of a low dropout voltage regulator with power-up reset for MPU power, two low dropout voltage regulators for independent powering of analog and digital circuitry, and a negative charge pump voltage regulator for full depletion of gallium arsenide MESFETs.

Also included are protective system shutdown features consisting of a battery latch that is activated upon battery insertion, low battery voltage shutdown, and a thermal over temperature detector. This device is available in a 16-pin narrow body surface mount plastic package.



### GaAs Power Amplifier Support IC

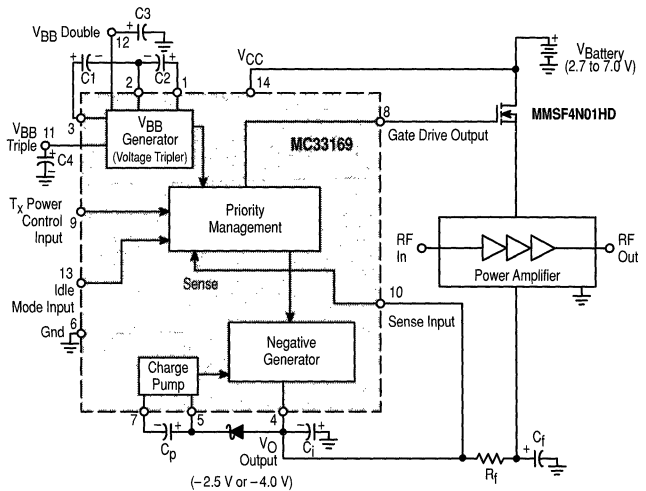
#### MC33169DTB

$T_A = -40^\circ$  to  $+85^\circ\text{C}$ , Case 948G

The MC33169 is a support IC for GaAs Power Amplifier Enhanced FETs used in hand portable telephones such as GSM, PCN and DECT. This device provides negative voltages for full depletion of Enhanced MESFETs as well as a priority management system of drain switching, ensuring that the negative voltage is always present before turning "on" the Power Amplifier. Additional features include an idle mode input and a direct drive of the N-Channel drain switch transistor.

This product is available in two versions,  $-2.5$  and  $-4.0$  V. The  $-4.0$  V version is intended for supplying RF modules for GSM and DCS1800 applications, whereas the  $-2.5$  V version is dedicated for DECT and PHS systems.

- Negative Regulated Output for Full Depletion of GaAs MESFETs
- Drain Switch Priority Management Circuit
- CMOS Compatible Inputs
- Idle Mode Input (Standby Mode) for Very Low Current Consumption
- Output Signal Directly Drives N-Channel FET
- Low Startup and Operating Current



# SCSI Regulator

**Table 5. SCSI Regulator**

Device	V <sub>out</sub> (V)		I <sub>sink</sub> (mA)	V <sub>in</sub> (V)		Reg <sub>line</sub> (%)	Reg <sub>load</sub> (%)	T <sub>J</sub> (°C)	Suffix/Package
	Min	Max		Min	Max				
MC34268	2.81	2.89	800	3.9	20	0.3	0.5	150	D/751, DT

## SCSI-2 Active Terminator Regulator

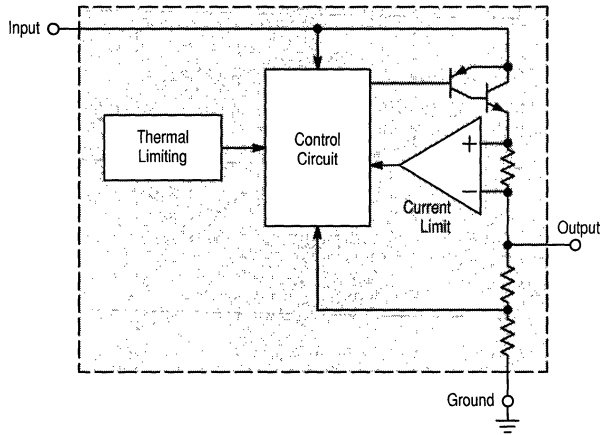
### MC34268D, DT

T<sub>J</sub> = 0° to +125°C, Case 751, 369A

The MC34268 is a medium current, low dropout positive voltage regulator specifically designed for use in SCSI-2 active termination circuits. This device offers the circuit designer an economical solution for precision voltage regulation, while keeping power losses to a minimum. The regulator consists of a 1.0 V dropout composite PNP/NPN pass transistor, current limiting, and thermal limiting. These devices are packaged in the 8-pin SOP-8 and 3-pin DPAK surface mount power packages.

Applications include active SCSI-2 terminators and post regulation of switching power supplies.

- 2.85 V Output Voltage for SCSI-2 Active Termination
- 1.0 V Dropout
- Output Current in Excess of 800 mA
- Thermal Protection
- Short Circuit Protection
- Output Trimmed to 1.4% Tolerance
- No Minimum Load Required
- Space Saving DPAK and SOP-8 Surface Mount Power Packages



# Switching Regulator Control Circuits

These devices contain the primary building blocks which are required to implement a variety of switching power supplies. The product offerings fall into three major categories consisting of single-ended and double-ended controllers, plus single-ended ICs with on-chip power switch transistors. These circuits operate in voltage, current or resonant modes

and are designed to drive many of the standard switching topologies. The single-ended configurations include buck, boost, flyback and forward converters. The double-ended devices control push-pull, half bridge and full bridge configurations.

**Table 6. Single-Ended Controllers**

These single-ended voltage and current mode controllers are designed for use in buck, boost, flyback, and forward converters. They are cost effective in applications that range from 0.1 to 200 W power output.

I <sub>O</sub> (mA) Max	Minimum Operating Voltage Range (V)	Operating Mode	Reference (V)	Maximum Useful Oscillator Frequency (kHz)	Device	T <sub>A</sub> (°C)	Suffix/ Package
500 (Uncommitted Drive Output)	7.0 to 40	Voltage	5.0 ± 1.5%	200	MC34060A	0 to +70	D/751A
							P/646
					MC33060A	-40 to +85	D/751A
							P/646
1000 (Totem Pole MOSFET Drive Output)	4.2 to 12	Current	1.25 ± 2.0%	300	MC34129	0 to +70	D/751A
							P/646
					MC33129	-40 to +85	D/751A
							P/646
	11.5 to 30		5.0 ± 2.0%	500	UC3842A	0 to +70	D/751A
							N/626
	11 to 30		5.0 ± 1.0%	500	UC2842A	-25 to +85	D/751A
							N/626
	8.2 to 30		5.0 ± 2.0%	500	UC3843A	0 to +70	D/751A
							N/626
	11.5 to 30		5.0 ± 1.0%	500	UC2843A	-25 to +85	D/751A
							N/626
	11.5 to 30		5.0 ± 2.0%	500 (50% Duty Cycle Limit)	UC3844	0 to +70	D/751A
							N/626
	11 to 30		5.0 ± 1.0%	500	UC2844	-25 to +85	D/751A
							N/626
	8.2 to 30		5.0 ± 2.0%	500	UC3845	0 to +70	D/751A
							N/626
	11.5 to 30		5.0 ± 1.0%	500	UC2845	-25 to +85	D/751A
							N/626
11.5 to 30	5.0 ± 2.0%	500 (Improved Oscillator Specifications with Frequency Guaranteed at 250 kHz)	UC3842B	0 to +70	D/751A		
					D1/751		
					N/626		
			UC3842BV	-40 to +105	D/751A		
				D1/751			
					N/626		



**Table 6. Single-Ended Controllers (continued)**

These single-ended voltage and current mode controllers are designed for use in buck, boost, flyback, and forward converters. They are cost effective in applications that range from 0.1 to 200 W power output.

$I_O$ (mA) Max	Minimum Operating Voltage Range (V)	Operating Mode	Reference (V)	Maximum Useful Oscillator Frequency (kHz)	Device	$T_A$ (°C)	Suffix/ Package
1000 (Totem Pole MOSFET Drive Output)	11 to 30	Current	$5.0 \pm 1.0\%$	500 (Improved Oscillator Specifications with Frequency Guaranteed at 250 kHz)	UC2842B	-25 to +85	D/751A
							D1/751
	N/626						
	8.2 to 30		UC3843B		0 to +70	D/751A	
						D1/751	
						N/626	
			UC3843BV		-40 to +105	D/751A	
						D1/751	
						N/626	
						UC2843B	-25 to +85
	D1/751						
	N/626						
	11.5 to 30	500 (50% Duty Cycle Limit)	UC3844B	0 to +70	D/751A		
					D1/751		
	UC3844BV		-40 to +105	D/751A			
				D1/751			
	11 to 30	UC2844B	-25 to +85	D/751A			
				D1/751			
	8.2 to 30	UC3845B	0 to +70	D/751A			
				D1/751			
UC3845BV		-40 to +105	D/751A				
			D1/751				
UC2845B		-25 to +85	D/751A				
			D1/751				
			N/626				
			MC44602	P2/648C			
1000 Source 1500 Sink (Split Totem Pole Bipolar Drive Output)	11 to 18		$5.0 \pm 6.0\%$				
2000 (Totem Pole MOSFET Drive Output)	9.2 to 30	Current or Voltage	$5.1 \pm 1.0\%$	1000	MC34023	0 to +70	DW/751G
							FN/775
							P/648
					MC33023	-40 to +105	DW/751G
							FN/775
							P/648

**Table 7. Single-Ended Controllers with On-Chip Power Switch**

These monolithic power switching regulators contain all the active functions required to implement standard dc-to-dc converter configurations with a minimum number of external components.

$I_O$ (mA) Max	Minimum Operating Voltage Range (V)	Operating Mode	Reference (V)	Maximum Useful Oscillator Frequency (kHz)	Device	$T_A$ (°C)	Suffix/ Package
1500 (Uncommitted Power Switch)	2.5 to 40	Voltage	$1.25 \pm 5.2\%$ <sup>(1)</sup>	100	$\mu A78S40$	0 to +70	PC/648
						-40 to +85	PV/648
			$1.25 \pm 2.0\%$		MC34063A	0 to +70	D/751
						-40 to +85	P1/626
			MC33063A		-40 to +85	D/751	
	-40 to +125	D/751					
1500 (Uncommitted Power Switch)	3.0 to 65	Voltage	$1.25 \pm 2.0\%$ and $5.05 \pm 3.0\%$	100	MC34165	0 to +70	P/648C, DW/751G
	MC33165				-40 to +85		
3400 (Uncommitted Power Switch)	2.5 to 40				MC34163	0 to +70	
	MC33163				-40 to +85		
3400 <sup>(2)</sup> (Dedicated Emitter Power Switch)	7.5 to 40					$5.05 \pm 2.0\%$	$72 \pm 12\%$ Internally Fixed
		MC33166	-40 to +85				
5500 <sup>(3)</sup> (Dedicated Emitter Power Switch)		MC34167	0 to +70				
		MC33167	-40 to +85				

<sup>(1)</sup> Tolerance applies over the specified operating temperature range.

<sup>(2)</sup> Guaranteed minimum, typically 4300 mA.

<sup>(3)</sup> Guaranteed minimum, typically 6500 mA.

**Table 8. Easy Switcher™ Single-Ended Controllers with On-Chip Power Switch**

The Easy Switcher™ series is ideally suited for easy, convenient design of a step-down switching regulator (buck converter), with a minimum number of external components.

$I_O$ (mA) Max	Minimum Operating Voltage Range (V)	Operating Mode	Oscillator Frequency (kHz)	Output Voltage (V)	Device	$T_J$ (°C)	Suffix/ Package				
1000	4.75 to 40 8.0 to 40 15 to 40 18 to 40 8.0 to 40	Voltage	52 Fixed Internal	3.3 5.0 12 15 1.23 to 37	LM2575T-3.3	-40 to +125	T/314D				
					LM2575T-5						
					LM2575T-12						
	4.75 to 40 8.0 to 40 15 to 40 18 to 40 8.0 to 40							3.3 5.0 12 15 1.23 to 37	LM2575TV-3.3		TV/314B
									LM2575TV-5		
									LM2575TV-12		
	4.75 to 40 8.0 to 40 15 to 40 18 to 40 8.0 to 40							3.3 5.0 12 15 1.23 to 37	LM2575D2T-3.3		D2T/936A
									LM2575D2T-5		
									LM2575D2T-12		

**Table 9. Very High Voltage Single-Ended Controller with On-Chip Power Switch**

This monolithic high voltage switching regulator is specifically designed to operate from a rectified ac line voltage source. Included are an on-chip high voltage power switch, active off-line startup circuitry and a full featured PWM controller with fault protection.

Power Switch Maximum Rating		Startup Input Max (V)	Operating Mode	Feedback Threshold (V)	Maximum Useful Oscillator Frequency (kHz)	Device	T <sub>J</sub> (°C)	Suffix/ Package	
V <sub>DS</sub> (V)	I <sub>DS</sub> (mA)								
500	2000	250	Voltage	2.6 ± 3.1%	1000	MC33362	-25 to +125	DW/751N, P/648E	
700	1000	450							MC33363
700	1000	450							MC33363A

**Table 10. Double-Ended Controllers**

These double-ended voltage, current and resonant mode controllers are designed for use in push-pull, half-bridge, and full-bridge converters. They are cost effective in applications that range from 100 to 2000 watts power output.

I <sub>O</sub> (mA) Max	Minimum Operating Voltage Range (V)	Operating Mode	Reference (V)	Maximum Useful Oscillator Frequency (kHz)	Device	T <sub>A</sub> (°C)	Suffix/ Package	
500 (Uncommitted Drive Outputs)	7.0 to 40	Voltage	5.0 ± 5.0% <sup>(1)</sup>	200	TL494	0 to +70	CN/648	
						-25 to +85	IN/648	
			5.0 ± 1.5%	300	TL594	0 to +70	CN/648	
						-25 to +85	IN/648	
± 500 (Totem Pole MOSFET Drive Outputs)	8.0 to 40		5.1 ± 2.0%	400	SG3525A	0 to +70	N/648	
± 200 (Totem Pole MOSFET Drive Outputs)			5.0 ± 2.0%			SG3526	0 to +125 <sup>(2)</sup>	N/707
±1500 (Totem Pole MOSFET Drive Outputs)	9.6 to 20		Resonant (Zero Current)	5.1 ± 2.0%	1000	MC34066	0 to +70	DW/751G
						MC33066	-40 to +85	DW/751G
		Resonant (Zero Voltage)	2000		MC34067	0 to +70	DW/751G	
							P/648	
					MC33067	-40 to +85	DW/751G	
2000 (Totem Pole MOSFET Drive Outputs)	9.2 to 30	Current or Voltage	5.1 ± 1.0%	1000	MC34025	0 to +70	DW/751G	
							FN/775	
							P/648	
					MC33025	-40 to +105	DW/751G	
							FN/775	
	P/648							

<sup>(1)</sup> Tolerance applies over the specified operating temperature range.

<sup>(2)</sup> Junction Temperature Range.

## Switching Regulator Control Circuits (continued)

### CMOS Micropower DC-to-DC Converters

#### Variable Frequency Micropower DC-to-DC Converter

##### MC33463H

$T_A = -30^\circ$  to  $+80^\circ\text{C}$ , Case 1213

The MC33463 series are micropower switching voltage regulators, specifically designed for handheld and laptop applications, to provide regulated output voltages using a minimum of external parts. A wide choice of output voltages are available. These devices feature a very low quiescent bias current of  $4.0\ \mu\text{A}$  typical.

The MC33463H-XXLT1 series features a highly accurate voltage reference, an oscillator, a variable frequency modulation (VFM) controller, a driver transistor (Lx), an error amplifier and feedback resistive divider.

The MC33463H-XXLT1 is identical to the MC33463H-XXKT1, except that a drive pin (EXT) for an external transistor is provided.

Due to the low bias current specifications, these devices are ideally suited for battery powered computer, consumer, and industrial equipment where an extension of useful battery life is desirable.

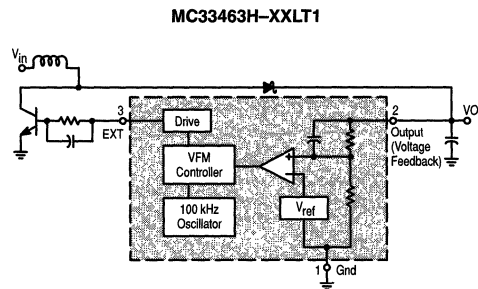
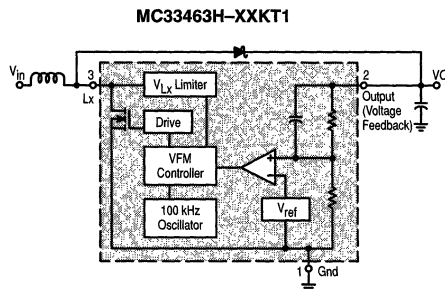
##### MC33463 Series Features:

- Low Quiescent Bias Current of  $4.0\ \mu\text{A}$
- High Output Voltage Accuracy of  $\pm 2.5\%$
- Low Startup Voltage of  $0.9\ \text{V}$  at  $1.0\ \text{mA}$
- Surface Mount Package

#### ORDERING INFORMATION

Device	Output Voltage	Type	Operating Temperature Range	Package (Tape/Reel)
MC33463H-30KT1	3.0	Int. Switch	$T_A = -30^\circ$ to $+80^\circ\text{C}$	SOT-89 (Tape)
MC33463H-33KT1	3.3			
MC33463H-50KT1	5.0			
MC33463H-30LT1	3.0	Ext. Switch Drive		SOT-89 (Tape)
MC33463H-33LT1	3.3			
MC33463H-50LT1	5.0			

Other voltages from 2.5 V to 7.5 V, in 0.1 V increments are available upon request. Consult your local Motorola sales office for information.



## CMOS Micropower DC-to-DC Converters (continued)

### Fixed Frequency PWM Micropower DC-to-DC Converter

#### MC33466H

$T_A = -30^\circ$  to  $+80^\circ\text{C}$ , Case 1213

The MC33466 series are micropower switching voltage regulators, specifically designed for handheld and laptop applications, to provide regulated output voltages using a minimum of external parts. A wide choice of output voltages are available. These devices feature a very low quiescent bias current of 15  $\mu\text{A}$  typical.

The MC33466H-XXJT1 series features a highly accurate voltage reference, an oscillator, a pulse width modulation (PWM) controller, a driver transistor (Lx), an error amplifier and feedback resistive divider.

The MC33466H-XXLT1 is identical to the MC33466H-XXJT1, except that a drive pin (EXT) for an external transistor is provided.

Due to the low bias current specifications, these devices are ideally suited for battery powered computer, consumer, and industrial equipment where an extension of useful battery life is desirable.

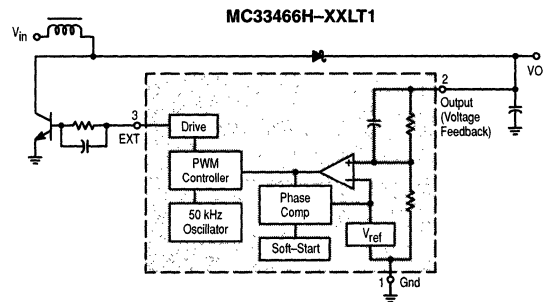
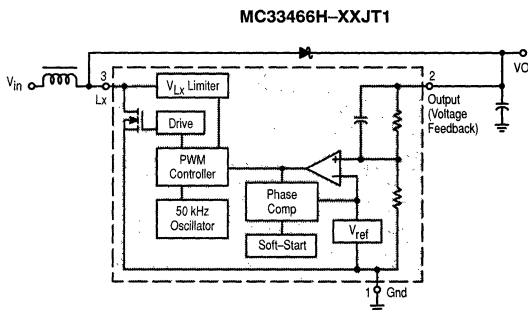
#### MC33466 Series Features:

- Low Quiescent Bias Current of 15  $\mu\text{A}$
- High Output Voltage Accuracy of  $\pm 2.5\%$
- Low Startup Voltage of 0.9 V at 1.0 mA
- Soft-Start = 500  $\mu\text{s}$
- Surface Mount Package

#### ORDERING INFORMATION

Device	Output Voltage	Type	Operating Temperature Range	Package (Tape/Reel)	
MC33466H-30JT1	3.0	Int. Switch	$T_A = -30^\circ$ to $+80^\circ\text{C}$	SOT-89 (Tape)	
MC33466H-33JT1	3.3				
MC33466H-50JT1	5.0				
MC33466H-30LT1	3.0	Ext. Switch Drive		$T_A = -30^\circ$ to $+80^\circ\text{C}$	SOT-89 (Tape)
MC33466H-33LT1	3.3				
MC33466H-50LT1	5.0				

Other voltages from 2.5 V to 7.5 V, in 0.1 V increments are available upon request. Consult your local Motorola sales office for information.



## Switching Regulator Control Circuits (continued)

### Single-Ended GreenLine™ Controllers

#### Mixed Frequency Mode GreenLine™ PWM Controller: Fixed Frequency, Variable Frequency, Standby Mode

##### MC44603P, DW

T<sub>A</sub> = -25° to +85°C, Case 648, 751G

The MC44603 is an enhanced high performance controller that is specifically designed for off-line and dc-to-dc converter applications. This device has the unique ability of automatically changing operating modes if the converter output is overloaded, unloaded, or shorted, offering the designer additional protection for increased system reliability. The MC44603 has several distinguishing features when compared to conventional SMPS controllers. These features consist of a foldback facility for overload protection, a standby mode when the converter output is slightly loaded, a demagnetization detection for reduced switching stresses on transistor and diodes, and a high current totem pole output ideally suited for driving a power MOSFET. It can also be used for driving a bipolar transistor in low power converters (< 150 W). It is optimized to operate in discontinuous mode but can also operate in continuous mode. Its advanced design allows use in current mode or voltage mode control applications.

##### Current or Voltage Mode Controller

- Operation up to 250 kHz Output Switching Frequency
- Inherent Feed Forward Compensation
- Latching PWM for Cycle-by-Cycle Current Limiting
- Oscillator with Precise Frequency Control

### High Safety Standby Ladder Mode GreenLine™ PWM Controller

##### MC44604P

T<sub>A</sub> = -25° to +85°C, Case 648

The MC44604 is an enhanced high performance controller that is specifically designed for off-line and dc-to-dc converter applications.

The MC44604 is a modification of the MC44603. The MC44604 offers enhanced safety and reliable power management in its protection features (foldback, overvoltage detection, soft-start, accurate demagnetization detection). Its high current totem pole output is also ideally suited for driving a power MOSFET but can also be used for driving a bipolar transistor in low power converters (< 150 W).

In addition, the MC44604 offers a new efficient way to reduce the standby operating power by means of a patented standby ladder mode operation of the converter significantly reducing the converter consumption in standby mode.

##### Current or Voltage Mode Controller

- Operation Up to 250 kHz Output Switching Frequency
- Inherent Feed Forward Compensation
- Latching PWM for Cycle-by-Cycle Current Limiting
- Oscillator with Precise Frequency Control

##### High Flexibility

- Externally Programmable Reference Current
- Secondary or Primary Sensing
- Synchronization Facility
- High Current Totem Pole Output
- Undervoltage Lockout with Hysteresis

##### Safety/Protection Features

- Overvoltage Protection Against Open Current and Open Voltage Loop
- Protection Against Short Circuit on Oscillator Pin
- Fully Programmable Foldback
- Soft-Start Feature
- Accurate Maximum Duty Cycle Setting
- Demagnetization (Zero Current Detection) Protection
- Internally Trimmed Reference

##### GreenLine Controller: Low Power Consumption in Standby Mode

- Low Startup and Operating Current
- Fully Programmable Standby Mode
- Controlled Frequency Reduction in Standby Mode
- Low dV/dT for Low EMI Radiations

##### High Flexibility

- Externally Programmable Reference Current
- Secondary or Primary Sensing
- High Current Totem Pole Output
- Undervoltage Lockout with Hysteresis

##### Safety/Protection Features

- Overvoltage Protection Facility Against Open Loop
- Protection Against Short Circuit on Oscillator Pin
- Fully Programmable Foldback
- Soft-Start Feature
- Accurate Maximum Duty Cycle Setting
- Demagnetization (Zero Current Detection) Protection
- Internally Trimmed Reference

##### GreenLine™ Controller:

- Low Startup and Operating Current
- Patented Standby Ladder Mode for Low Standby Losses
- Low dV/dT for Low EMI

## Single-Ended GreenLine™ Controllers (continued)

### High Safety Latched Mode GreenLine™ PWM Controller for (Multi)Synchronized Applications

#### MC44605P

$T_A = -25^\circ$  to  $+85^\circ\text{C}$ , Case 648

The MC44605 is a high performance current mode controller that is specifically designed for off-line converters. The MC44605 has several distinguishing features that make it particularly suitable for multisynchronized monitor applications.

The MC44605 synchronization arrangement enables operation from 16 kHz up to 130 kHz. This product was optimized to operate with universal ac mains voltage from 80 V to 280 V, and its high current totem pole output makes it ideally suited for driving a power MOSFET.

The MC44605 protections provide well controlled, safe power management. Safety enhancements detect four different fault conditions and provide protection through a disabling latch.

#### Current or Voltage Mode Controller

- Current Mode Operation Up to 250 kHz Output Switching Frequency
- Inherent Feed Forward Compensation
- Latching PWM for Cycle-by-Cycle Current Limiting
- Oscillator with Precise Frequency Control
- Externally Programmable Reference Current
- Secondary or Primary Sensing (Availability of Error Amplifier Output)
- Synchronization Facility

- High Current Totem Pole Output
- Undervoltage Lockout with Hysteresis
- Low Output  $dV/dT$  for Low EMI
- Low Startup and Operating Current

#### Safety/Protection Features

- Soft-Start Feature
- Demagnetization (Zero Current Detection) Protection
- Overvoltage Protection Facility Against Open Loop
- EHT Overvoltage Protection (E.H.T.OVP): Protection Against Excessive Amplitude Synchronization Pulses
- Winding Short Circuit Detection (W.S.C.D.)
- Limitation of the Maximum Input Power (M.P.L.): Calculation of Input Power for Overload Protection
- Over Heating Detection (O.H.D.): to Prevent the Power Switch from Excessive Heating

#### Latched Disabling Mode

- When one of the following faults is detected: EHT overvoltage, Winding Short Circuit (WSCD), excessive input power (M.P.L.), power switch over heating (O.H.D.), a counter is activated
- If the counter is activated for a time that is long enough, the circuit gets definitively disabled. The latch can only be reset by removing and then re-applying power





## Switching Regulator Control Circuits (continued)

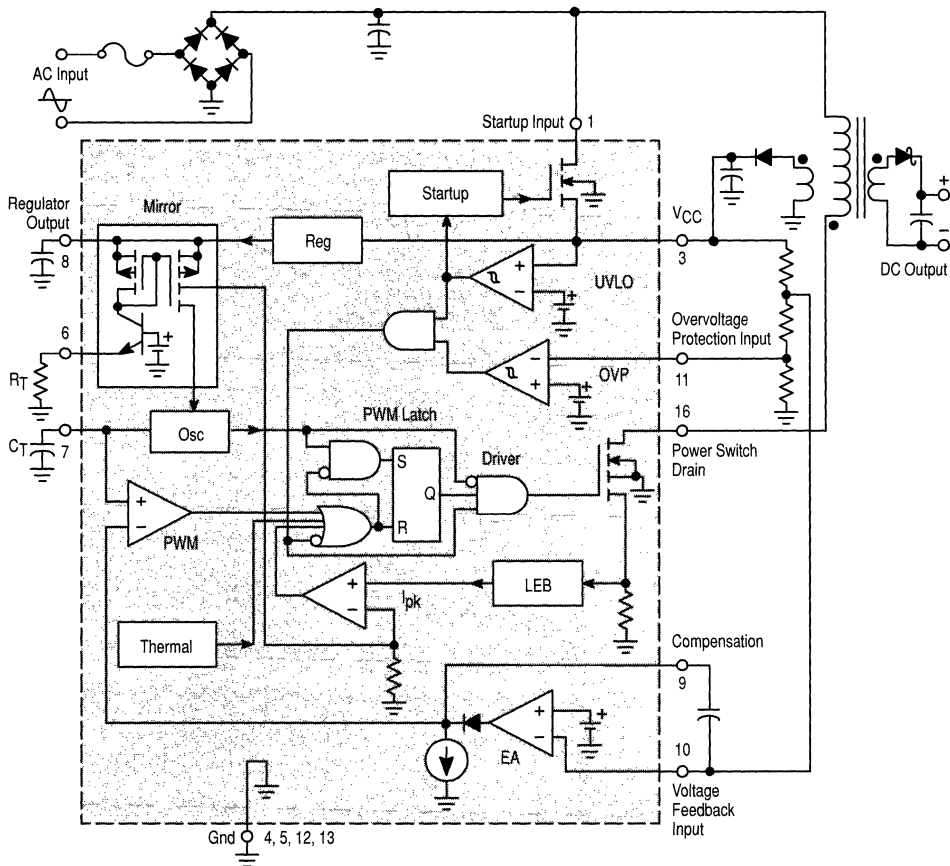
### Very High Voltage Switching Regulator

MC33363DW, P, MC33363ADW, P

$T_J = -25^\circ$  to  $+125^\circ\text{C}$ , Case 751N, 648E

The MC33363 is a monolithic high voltage switching regulator that is specifically designed to operate from a rectified 240 Vac line source. This integrated circuit features an on-chip 700 V/1.0 A (1.5 A in MC33363A) SenseFET power switch, 450 V active off-line startup FET, duty cycle controlled oscillator, current limiting comparator with a programmable threshold and leading edge blanking, latching pulse width modulator for double pulse suppression, high gain error amplifier, and a trimmed internal bandgap reference. Protective features include cycle-by-cycle current limiting, input undervoltage lockout with hysteresis, output overvoltage protection, and thermal shutdown. This device is available in a 16-lead wide body surface mount package.

- On-Chip 700 V, 1.0 A SenseFET Power Switch
- On-Chip 700 V, 1.5 A SenseFET Power Switch in MC33363A
- Rectified 240 Vac Line Source Operation
- On-Chip 450 V Active Off-Line Startup FET
- Latching PWM for Double Pulse Suppression
- Cycle-By-Cycle Current Limiting
- Input Undervoltage Lockout with Hysteresis
- Output Overvoltage Protection Comparator
- Trimmed Internal Bandgap Reference
- Internal Thermal Shutdown



## Critical Conduction SMPS Controller

### MC33364D, D1, D2

$T_J = -25^\circ$  to  $+125^\circ\text{C}$ , Case 751, 751B

The MC33364 series are variable frequency SMPS controllers that operate in the critical conduction mode. They are optimized for low power, high density power supplies requiring minimum board area, reduced component count, and low power dissipation. Each narrow body SOIC package provides a small footprint. Integration of the high voltage startup saves approximately 0.7 W of power compared to resistor bootstrapped circuits.

Each MC33364 features an on-board reference, UVLO function, a watchdog timer to initiate output switching, a zero current detector to ensure critical conduction operation, a current sensing comparator, leading edge blanking, and a CMOS driver. Protection features include the ability to shut down switching, and cycle-by-cycle current limiting.

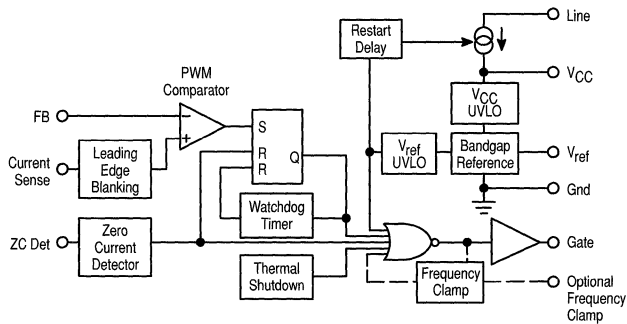
The MC33364D1 is available in a surface mount SO-8 package. It has an internal 144 kHz frequency clamp. For loads which have a low power operating condition, the fre-

quency clamp limits the maximum operating frequency, preventing excessive switching losses and EMI radiation.

The MC33364D2 is available in the SO-8 package without an internal frequency clamp.

The MC33364D is available in the SO-16 package. It has an internal 144 kHz frequency clamp which is pinned out, so that the designer can adjust the clamp frequency by connecting appropriate values of resistance and capacitance.

- Lossless Off-Line Startup
- Leading Edge Blanking for Noise Immunity
- Watchdog Timer to Initiate Switching
- Minimum Number of Support Components
- Shutdown Capability
- Over Temperature Protection
- Optional Frequency Clamp



# Special Switching Regulator Controllers

These high performance dual channel controllers are optimized for off-line, ac-to-dc power supplies and dc-to-dc converters in the flyback topology. They also have undervoltage lockout voltages which are optimized for off-line

and lower voltage dc-to-dc converters, respectively. Applications include desktop computers, peripherals, televisions, games, and various consumer appliances.

**Table 11. Dual Channel Controllers**

$I_O$ (mA) Max	Minimum Operating Voltage Range (V)	Operating Mode	Reference (V)	Maximum Useful Oscillator Frequency (kHz)	Device	$T_A$ (°C)	Suffix/ Package
500	4.0	Voltage	$1.25 \pm 2.0\%$	700	MC34270 MC34271	0 to +70	FB/873A
$\pm 1000$ (Totem Pole MOSFET Drive Outputs)	11 to 15.5	Current	$5.0 \pm 2.6\%$	500	MC34065	0 to +70	DW/751G P/648
					MC33065	-40 to +85	DW/751G P/648
	11 to 20				MC34065	0 to +70	DW-H/751G P-H/648
					MC33065	-40 to +85	DW-H/751G P-H/648
	8.4 to 20				MC34065	0 to +70	DW-L/751G P-L/648
					MC33065	-40 to +85	DW-L/751G P-L/648

**Table 12. Universal Microprocessor Power Supply Controllers**

A versatile power supply control circuit for microprocessor-based systems, this device is mainly intended for automotive applications and battery powered instruments. The circuit provides a power-on reset delay and a Watchdog feature for orderly microprocessor operation.

Regulated Outputs	Output Current (mA)	$V_{CC}$ (V)		Reference (V)	Key Supervisory Features	Device	$T_A$ (°C)	Package
		Min	Max					
E <sup>2</sup> PROM Programmable Output: 24 V (Write Mode) 5.0 V (Read Mode)	150 peak	6.0	35	$2.5 \pm 3.2\%$	MPU Reset and Watchdog Circuit	TCF5600	-40 to +85	707

**Table 13. Power Factor Controllers**

$I_O$ (mA) Max	Minimum Operating Voltage Range (V)	Maximum Startup Voltage (V)	Reference (V)	Features	Device	$T_A$ (°C)	Suffix/ Package
± 500 (Totem Pole MOSFET Drive Outputs)	9.0 to 30	30	2.5 ± 1.4%	Undervoltage Lockout, Internal Startup Timer	MC34261	0 to +70	D/751
							P/626
					MC33261	-40 to +85	D/751
							P/626
				Overvoltage Comparator, Undervoltage Lockout, Internal Startup Timer	MC34262	0 to +85	D/751
							P/626
		MC33262	-40 to +105	D/751			
				P/626			
1500 (CMOS Totem Pole MOSFET Drive Outputs)	9.0 to 16	500	5.0 ± 1.5%	Off-Line High Voltage Startup Overvoltage Comparator, Undervoltage Lockout, Timer, Low Load Detect	MC33368	-25 to +125	D/751K

# Power Factor Controllers

## MC34262D, P

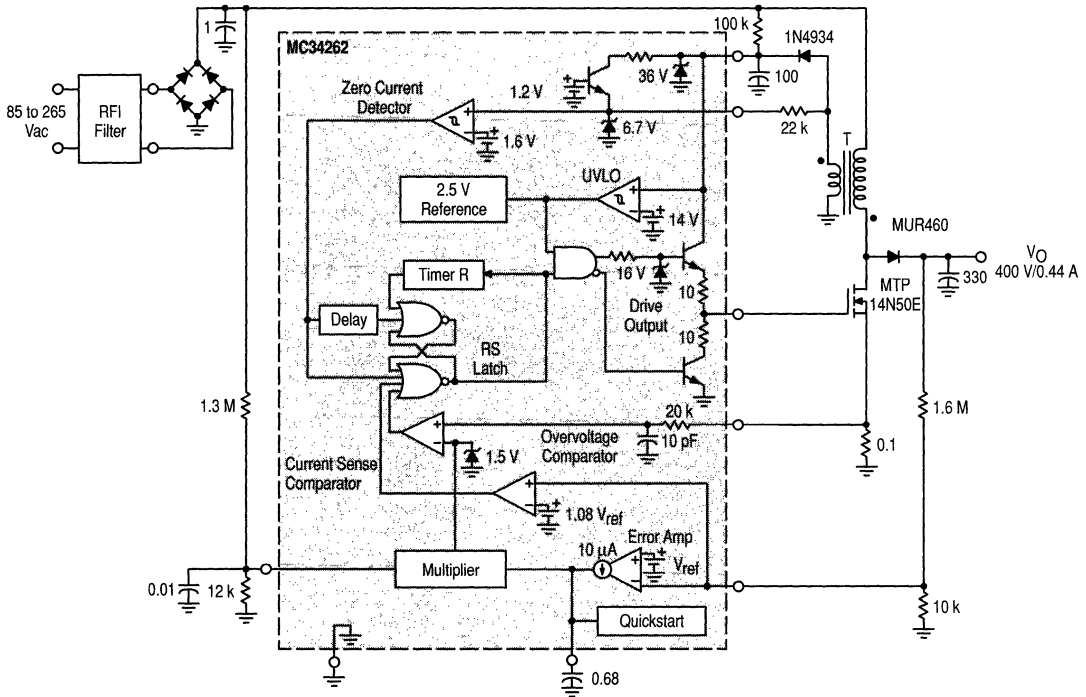
$T_A = 0^\circ$  to  $+85^\circ\text{C}$ , Case 751, 626

## MC33262D, P

$T_A = -40^\circ$  to  $+105^\circ\text{C}$ , Case 751, 626

The MC34262, MC33262 series are active power factor controllers specifically designed for use as a preconverter in electronic ballast and in off-line power converter applications. These integrated circuits feature an internal startup timer for stand alone applications, a one quadrant multiplier for near unity power factor, zero current detector to ensure critical conduction operation, transconductance error amplifier, quickstart circuit for enhanced startup, trimmed internal bandgap reference, current sensing comparator, and a totem pole output ideally suited for driving a power MOSFET.

Also included are protective features consisting of an overvoltage comparator to eliminate runaway output voltage due to load removal, input undervoltage lockout with hysteresis, cycle-by-cycle current limiting, multiplier output clamp that limits maximum peak switch current, an RS latch for single pulse metering, and a drive output high state clamp for MOSFET gate protection. These devices are available in dual-in-line and surface mount plastic packages.



## Power Factor Controllers (continued)

### MC33368D

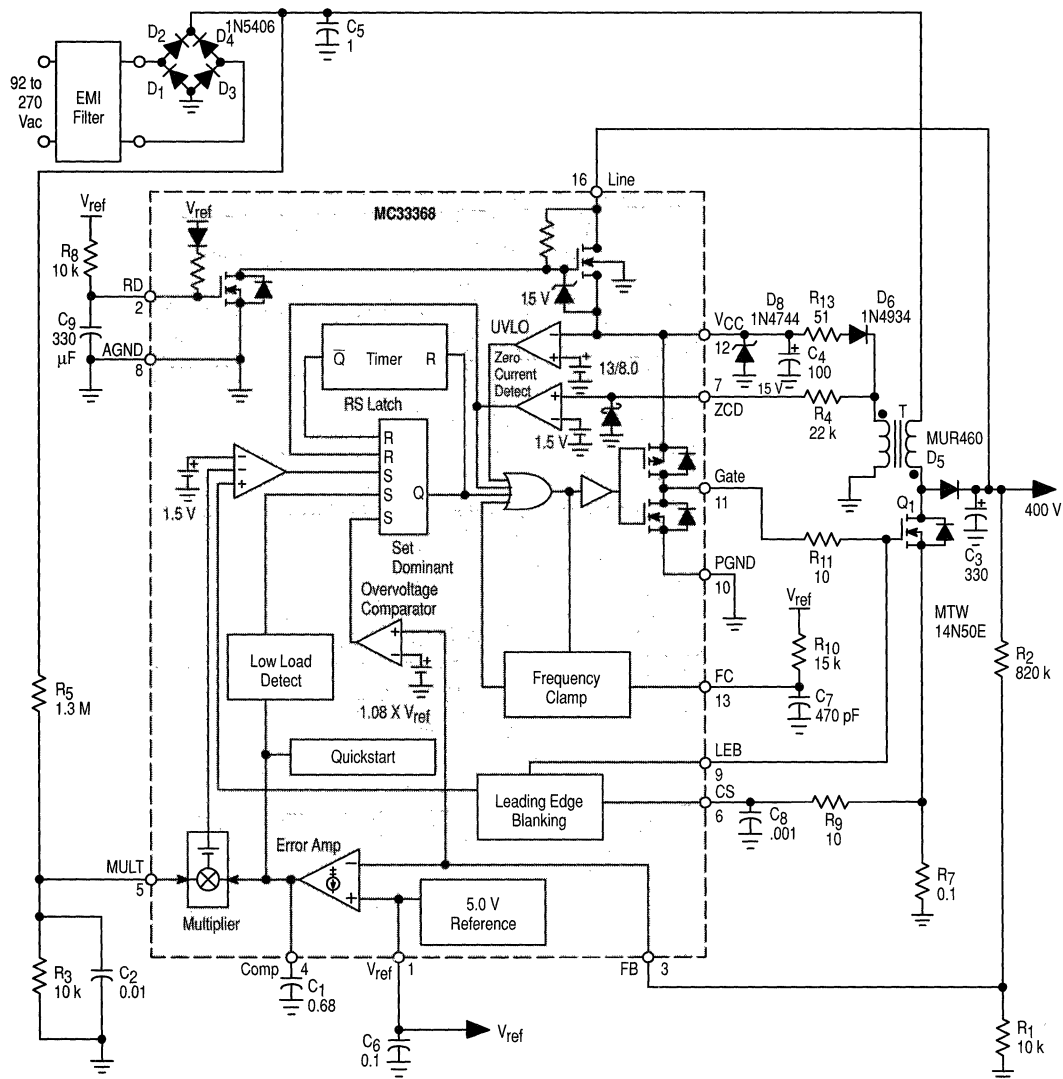
$T_J = -25^\circ$  to  $+125^\circ\text{C}$ , Case 751K

The MC33368 is an active power factor controller that functions as a boost preconverter in off-line power supply applications. MC33368 is optimized for low power, high density power supplies requiring minimum board area, reduced component count, and low power dissipation. The narrow body SOIC package provides a small footprint. Integration of the high voltage startup saves approximately 0.7 W of power compared to resistor bootstrapped circuits.

The MC33368 features a watchdog timer to initiate output switching, a one quadrant multiplier to force the line current to follow the instantaneous line voltage, a zero current detector to ensure critical conduction operation, a transconductance error amplifier, a current sensing comparator, a 5.0 V

reference, an undervoltage lockout (UVLO) circuit which monitors the  $V_{CC}$  supply voltage, and a CMOS driver for driving MOSFETs. The MC33368 also includes a programmable output switching frequency clamp. Protection features include an output overvoltage comparator to minimize overshoot, a restart delay timer, and cycle-by-cycle current limiting.

- Lossless Off-Line Startup
- Output Overvoltage Comparator
- Leading Edge Blanking (LEB) for Noise Immunity
- Watchdog Timer to Initiate Switching
- Restart Delay Timer



# Supervisory Circuits

A variety of Power Supervisory Circuits are offered. Overvoltage sensing circuits which drive "Crowbar" SCRs are provided in several configurations from a low cost three-terminal version to 8-pin devices which provide

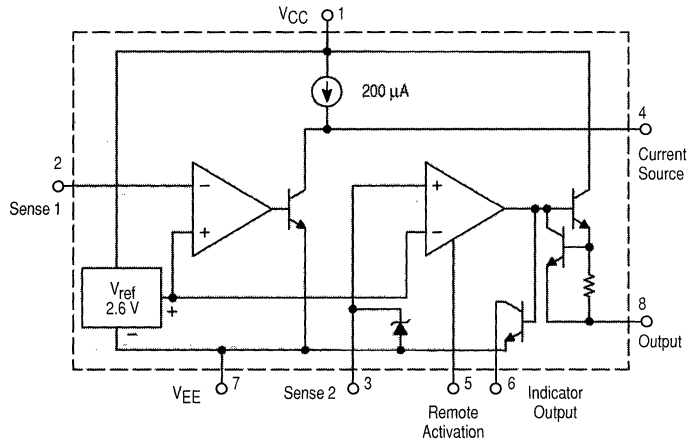
pin-programmable trip voltages or additional features, such as an indicator output drive and remote activation capability. An over/undervoltage protection circuit is also offered.

## Overvoltage Crowbar Sensing Circuit

### MC3423P1, D

$T_A = 0^\circ$  to  $+70^\circ\text{C}$ , Case 626, 751

This device can protect sensitive circuitry from power supply transients or regulator failure when used with an external "Crowbar" SCR. The device senses voltage and compares it to an internal 2.6 V reference. Overvoltage trip is adjustable by means of an external resistive voltage divider. A minimum duration before trip is programmable with an external capacitor. Other features include a 300 mA high current output for driving the gate of a "Crowbar" SCR, an open-collector indicator output and remote activation capability.

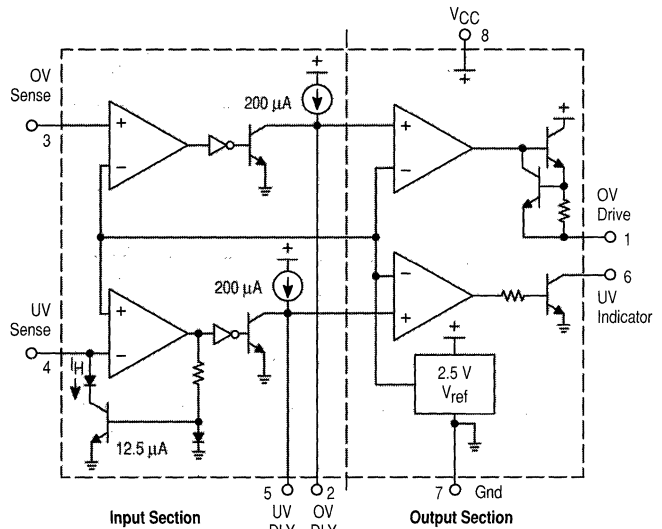


## Over/Undervoltage Protection Circuit

### MC3425P1

$T_A = 0^\circ$  to  $+70^\circ\text{C}$ , Case 626

The MC3425 is a power supply supervisory circuit containing all the necessary functions required to monitor over and undervoltage fault conditions. This device features dedicated over and undervoltage sensing channels with independently programmable time delays. The overvoltage channel has a high current drive output for use in conjunction with an external SCR "Crowbar" for shutdown. The undervoltage channel input comparator has hysteresis which is externally programmable, and an open-collector output for fault indication.



## Supervisory Circuits (continued)

# CMOS Micropower Undervoltage Sensing Circuits

### MC33464H, N

$T_A = -30^\circ$  to  $+80^\circ\text{C}$ , Case 1213, 1212

The MC33464 series are micropower undervoltage sensing circuits that are specifically designed for use with battery powered microprocessor based systems, where extended battery life is required. A choice of several threshold voltages from 0.9 V to 4.5 V are available. These devices feature a very low quiescent bias current of 0.8  $\mu\text{A}$  typical.

The MC33464 series features a highly accurate voltage reference, a comparator with precise thresholds and built-in hysteresis to prevent erratic reset operation, a choice of output configurations between open drain or complementary MOS, and guaranteed operation below 1.0 V with extremely low standby current. These devices are available in either SOT-89 3-pin or SOT-23 5-pin surface mount packages.

Applications include direct monitoring of the MPU/logic power supply used in portable, appliance, automotive and industrial equipment.

#### MC33464 Features:

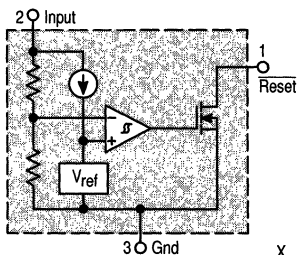
- Extremely Low Standby Current of 0.8  $\mu\text{A}$  at  $V_{in} = 1.5\text{ V}$
- Wide Input Voltage Range (0.7 V to 10 V)
- Monitors Power Supply Voltages from 1.1 V to 5.0 V
- High Accuracy Detector Threshold ( $\pm 2.5\%$ )
- Two Reset Output Types (Open Drain or Complementary Drive)
- Two Surface Mount Packages (SOT-89 or SOT-23 5-Pin)

### ORDERING INFORMATION

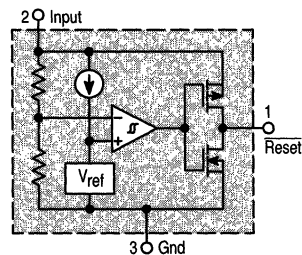
Device	Threshold Voltage	Type	Operating Temperature Range	Package (Qty/Reel)		
MC33464H-09AT1	0.9	Open Drain Reset	$T_A = -30^\circ$ to $+80^\circ\text{C}$	SOT-89 (1000)		
MC33464H-20AT1	2.0					
MC33464H-27AT1	2.7					
MC33464H-30AT1	3.0					
MC33464H-45AT1	4.5					
MC33464H-09CT1	0.9	Compl. MOS Reset			$T_A = -30^\circ$ to $+80^\circ\text{C}$	SOT-23 (3000)
MC33464H-20CT1	2.0					
MC33464H-27CT1	2.7					
MC33464H-30CT1	3.0					
MC33464H-45CT1	4.5					
MC33464N-09ATR	0.9	Open Drain Reset	$T_A = -30^\circ$ to $+80^\circ\text{C}$	SOT-23 (3000)		
MC33464N-20ATR	2.0					
MC33464N-27ATR	2.7					
MC33464N-30ATR	3.0					
MC33464N-45ATR	4.5					
MC33464N-09CTR	0.9	Compl. MOS Reset			$T_A = -30^\circ$ to $+80^\circ\text{C}$	SOT-23 (3000)
MC33464N-20CTR	2.0					
MC33464N-27CTR	2.7					
MC33464N-30CTR	3.0					
MC33464N-45CTR	4.5					

Other voltages from 0.9 to 6.0 V, in 0.1 V increments, are available upon request. Consult your local Motorola sales office for information.

**MC33464X-YYATZ**  
Open Drain Configuration



**MC33464X-YYCTZ**  
Complementary Drive Configuration



X Denotes Package Type  
YY Denotes Threshold Voltage  
TZ Denotes Taping Type



## Supervisory Circuits (continued)

# CMOS Micropower Undervoltage Sensing Circuits with Output Delay

### MC33465N

$T_A = -30^\circ$  to  $+80^\circ\text{C}$ , Case 1212

The MC33465 series are micropower undervoltage sensing circuits that are specifically designed for use with battery powered microprocessor based systems, where extended battery life is required. A choice of several threshold voltages from 0.9 V to 4.5 V are available. This device features a very low quiescent bias current of 1.0  $\mu\text{A}$  typical.

The MC33465 series features a highly accurate voltage reference, a comparator with precise thresholds and built-in hysteresis to prevent erratic reset operation, a choice of output configurations between open drain or complementary MOS, a time delayed output, which can be programmed by the system designer, and guaranteed operation below 1.0 V with extremely low standby current. This device is available in a SOT-23 5-pin surface mount packages.

Applications include direct monitoring of the MPU/logic power supply used in portable, appliance, automotive and industrial equipment.

#### MC33465 Features:

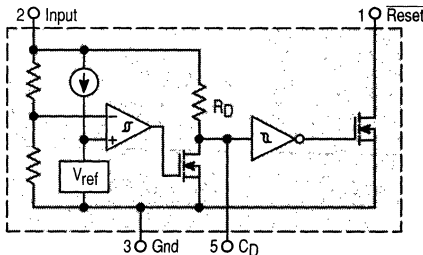
- Extremely Low Standby Current of 1.0  $\mu\text{A}$  at  $V_{\text{IN}} = 3.5\text{ V}$
- Wide Input Voltage Range (0.7 V to 10 V)
- Monitors Power Supply Voltages from 1.1 V to 5.0 V
- High Accuracy Detector Threshold ( $\pm 2.5\%$ )
- Two Reset Output Types (Open Drain or Complementary Drive)
- Programmable Output Delay by External Capacitor (100 ms typ. with 0.15  $\mu\text{F}$ )
- Surface Mount Package (SOT-23 5-Pin)
- Convenient Tape and Reel (3000 per Reel)

### ORDERING INFORMATION

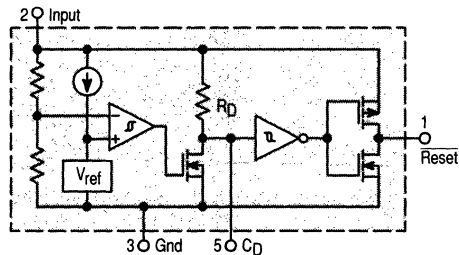
Device	Threshold Voltage	Type	Operating Temperature Range	Package		
MC33465N-09ATR	0.9	Open Drain <u>Reset</u>	$T_A = -30^\circ$ to $+80^\circ\text{C}$	SOT-23		
MC33465N-20ATR	2.0					
MC33465N-27ATR	2.7					
MC33465N-30ATR	3.0					
MC33465N-45ATR	4.5					
MC33465N-09CTR	0.9	Compl. MOS <u>Reset</u>			$T_A = -30^\circ$ to $+80^\circ\text{C}$	SOT-23
MC33465N-20CTR	2.0					
MC33465N-27CTR	2.7					
MC33465N-30CTR	3.0					
MC33465N-45CTR	4.5					

Other voltages from 0.9 to 6.0 V, in 0.1 V increments, are available upon request. Consult your local Motorola sales office for information.

MC33465N-YYATZ  
Open Drain Configuration



MC33465N-YYCTZ  
Complementary Drive Configuration



YY Denotes Threshold Voltage  
TZ Denotes Taping Type

## Supervisory Circuits (continued)

### Undervoltage Sensing Circuit

#### MC34064P-5, D-5, DM-5

$T_A = 0^\circ$  to  $+70^\circ\text{C}$ , Case 29, 751, 846A

#### MC33064P-5, D-5, DM-5

$T_A = -40^\circ$  to  $+85^\circ\text{C}$ , Case 29, 751, 846A

#### MC34164P-3, P-5, D-3, D-5, DM-3, DM-5

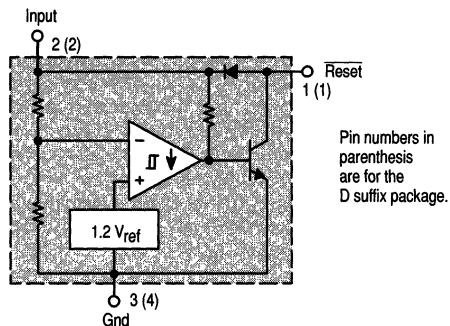
$T_A = 0^\circ$  to  $+70^\circ\text{C}$ , Case 29, 751, 846A

#### MC33164P-3, P-5, D-3, D-5, DM-3, DM-5

$T_A = -40^\circ$  to  $+85^\circ\text{C}$ , Case 29, 751, 846A

The MC34064 and MC34164 are two families of undervoltage sensing circuits specifically designed for use as reset controllers in microprocessor-based systems. They offer the designer an economical solution for low voltage detection with a single external resistor. Both parts feature a trimmed bandgap reference, and a comparator with precise thresholds and built-in hysteresis to prevent erratic reset operation.

The two families of undervoltage sensing circuits taken together, cover the needs of the most commonly specified power supplies used in MCU/MPU systems. Key parameter specifications of the MC34164 family were chosen to complement the MC34064 series. The table summarizes critical parameters of both families. The MC34064 fulfills the needs of a  $5.0\text{ V} \pm 5\%$  system and features a tighter hysteresis specification. The MC34164 series covers  $5.0\text{ V} \pm 10\%$  and



$3.0\text{ V} \pm 5\%$  power supplies with significantly lower power consumption, making them ideal for applications where extended battery life is required such as consumer products or hand held equipment.

Applications include direct monitoring of the  $5.0\text{ V}$  MPU/logic power supply used in appliance, automotive, consumer, and industrial equipment.

The MC34164 is specifically designed for battery powered applications where low bias current ( $1/25$ th of the MC34064's) is an important characteristic.

**Table 14. Undervoltage Sense/Reset Controller Features**

MC34X64 devices are specified to operate from  $0^\circ$  to  $+70^\circ\text{C}$ , and MC33X64 devices operate from  $-40^\circ$  to  $+85^\circ\text{C}$ .

Device	Standard Power Supply Supported	Typical Threshold Voltage (V)	Typical Hysteresis Voltage (V)	Minimum Output Sink Current (mA)	Power Supply Input Voltage Range (V)	Maximum Quiescent Input Current	Suffix/Package
MC34064/MC33064	$5.0\text{ V} \pm 5\%$	4.6	0.02	10	1.0 to 10	500 $\mu\text{A}$ @ $V_{in} = 5.0\text{ V}$	P-5/29
							D-5/751
							DM-5/846A
MC34164/MC33164	$5.0\text{ V} \pm 10\%$	4.3	0.09	7.0	1.0 to 12	20 $\mu\text{A}$ @ $V_{in} = 5.0\text{ V}$	P-5/29
							D-5/751
							DM-5/846A
MC34164/MC33164	$3.0\text{ V} \pm 5\%$	2.7	0.06	6.0	1.0 to 12	15 $\mu\text{A}$ @ $V_{in} = 3.0\text{ V}$	P-3/29
							D-3/751
							DM-3/846A

## Supervisory Circuits (continued)

### Universal Voltage Monitor

#### MC34161P, D

$T_A = 0^\circ$  to  $+70^\circ\text{C}$ , Case 626, 751

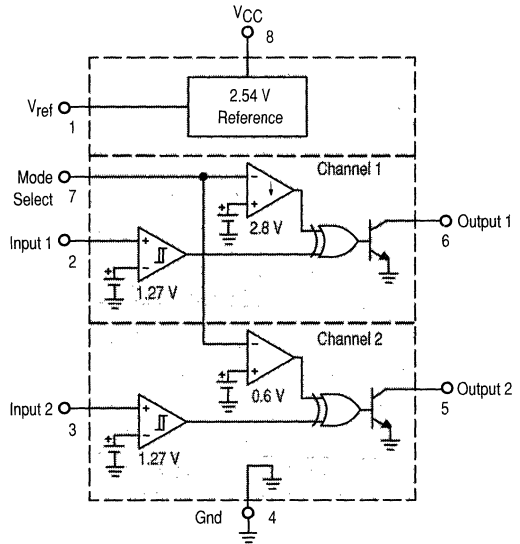
The MC34161, MC33161 series are universal voltage monitors intended for use in a wide variety of voltage sensing applications. These devices offer the circuit designer an economical solution for positive and negative voltage detection. The circuit consists of two comparator channels each with hysteresis, a unique Mode Select Input for channel programming, a pinned out 2.54 V reference, and two open collector outputs capable of sinking in excess of 10 mA. Each comparator channel can be configured as either inverting or noninverting by the Mode Select Input. This allows over, under, and window detection of positive and negative voltages. The minimum supply voltage needed for these devices to be fully functional is 2.0 V for positive voltage sensing and 4.0 V for negative voltage sensing.

Applications include direct monitoring of positive and negative voltages used in appliance, automotive, consumer, and industrial equipment.

- Unique Mode Select Input Allows Channel Programming
- Over, Under, and Window Voltage Detection
- Positive and Negative Voltage Detection
- Fully Functional at 2.0 V for Positive Voltage Sensing and 4.0 V for Negative Voltage Sensing
- Pinned Out 2.54 V Reference with Current Limit Protection
- Low Standby Current
- Open Collector Outputs for Enhanced Device Flexibility

#### MC33161P, D

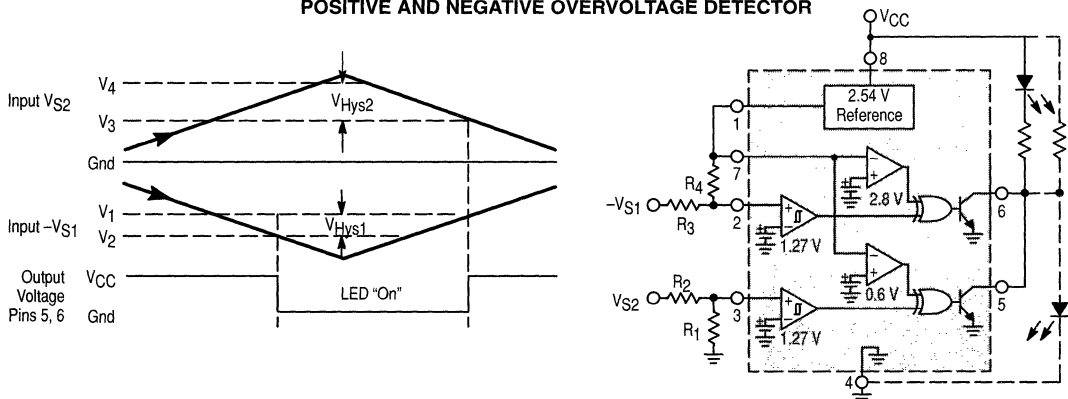
$T_A = -40^\circ$  to  $+85^\circ\text{C}$ , Case 626, 751



#### TRUTH TABLE

Mode Select Pin 7	Input 1 Pin 2	Output 1 Pin 6	Input 2 Pin 3	Output 2 Pin 5	Comments
GND	0 1	0 1	0 1	0 1	Channels 1 & 2: Noninverting
$V_{ref}$	0 1	0 1	0 1	1 0	Channel 1: Noninverting Channel 2: Inverting
$V_{CC} (>2.0\text{ V})$	0 1	1 0	0 1	1 0	Channels 1 & 2: Inverting

#### POSITIVE AND NEGATIVE OVERVOLTAGE DETECTOR



# Battery Management Circuits

## Battery Charger ICs

### Battery Fast Charge Controller

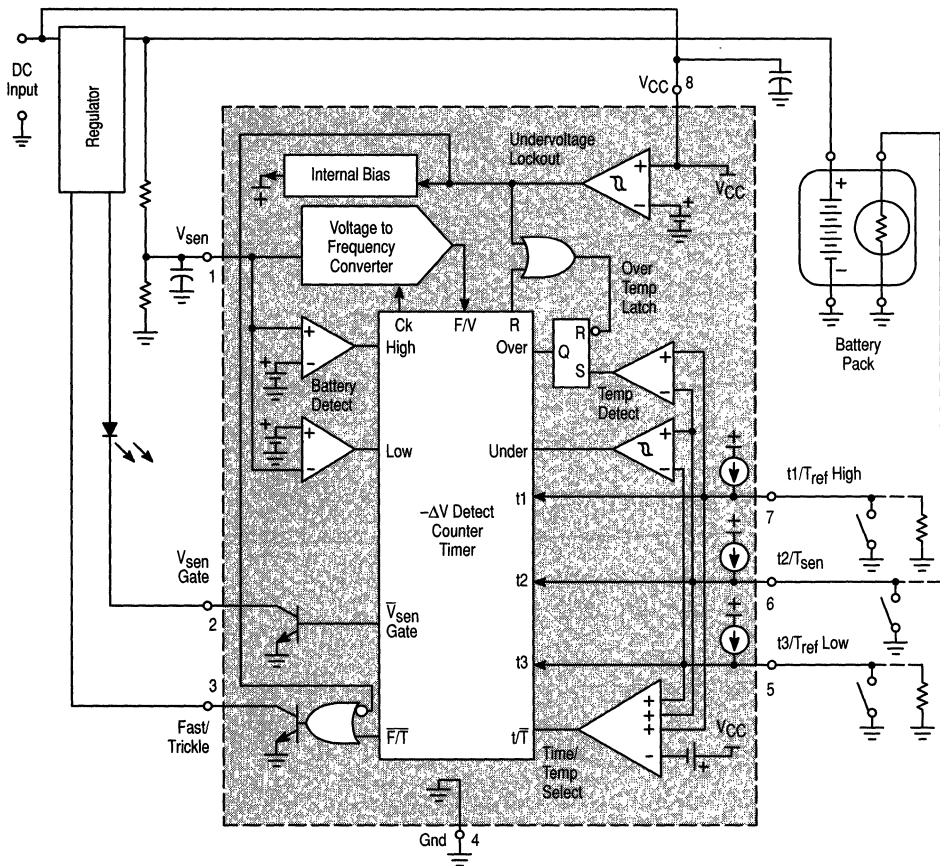
MC33340P, D

$T_A = -25^\circ$  to  $+85^\circ\text{C}$ , Case 626, 751

The MC33340 is a monolithic control IC that is specifically designed as a fast charge controller for Nickel Cadmium (NiCd) and Nickel Metal Hydride (NiMH) batteries. This device features negative slope voltage detection as the primary means for fast charge termination. Accurate detection is ensured by an output that momentarily interrupts the charge current for precise voltage sampling. An additional secondary backup termination method can be selected that consists of either a programmable time or temperature limit. Protective features include battery over and undervoltage detection, latched over temperature detection, and power supply input undervoltage lockout with hysteresis. Provisions for entering

a rapid test mode are available for enhanced end product testing. This device is available in an economical 8-lead surface mount package.

- Negative Slope Voltage Detection
- Accurate Zero Current Battery Voltage Sensing
- Programmable 1 to 4 Hour Fast Charge Time Limit
- Programmable Over/Under Temperature Detection
- Battery Over and Undervoltage Fast Charge Protection
- Rapid System Test Mode
- Power Supply Input Undervoltage Lockout with Hysteresis
- Operating Voltage Range of 3.0 V to 18 V



## Battery Charger ICs (continued)

### Power Supply

### Battery Charger

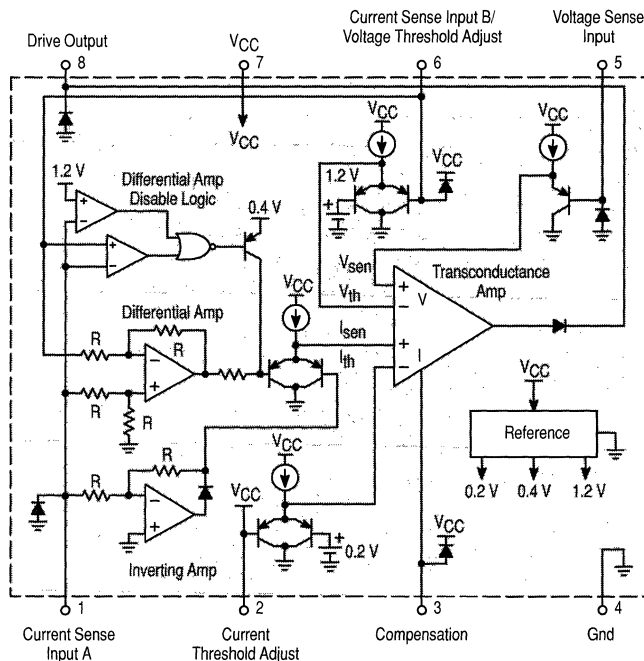
### Regulation Control Circuit

#### MC33341P, D

$T_A = -40^\circ$  to  $+85^\circ\text{C}$ , Case 626, 751

The MC33341 is a monolithic regulation control circuit that is specifically designed to close the voltage and current feedback loops in power supply and battery charger applications. This device features the unique ability to perform source high-side, load high-side, source low-side, and load low-side current sensing, each with either an internally fixed or externally adjustable threshold. The various current sensing modes are accomplished by a means of selectively using the internal differential amplifier, inverting amplifier, or a direct input path. Positive voltage sensing is performed by an internal voltage amplifier. The voltage amplifier threshold is internally fixed and can be externally adjusted in all low-side current sensing applications. An active high drive output is provided to directly interface with economical optoisolators for isolated output power systems. This device is available in 8-lead dual-in-line and surface mount packages.

- Differential Amplifier for High-Side Source and Load Current Sensing
- Inverting Amplifier for Source Return Low-Side Current Sensing
- Noninverting Input Path for Load Low-Side Current Sensing
- Fixed or Adjustable Current Threshold in all Current Sensing Modes
- Positive Voltage Sensing in all Current Sensing Modes
- Fixed Voltage Threshold in all Current Sensing Modes
- Adjustable Voltage Threshold in all Low-Side Current Sensing Modes
- Output Driver Directly Interfaces with Economical Optoisolators
- Operating Voltage Range of 2.3 V to 18 V



# Battery Pack ICs

## Lithium Battery Protection Circuit for One to Four Cell Battery Packs

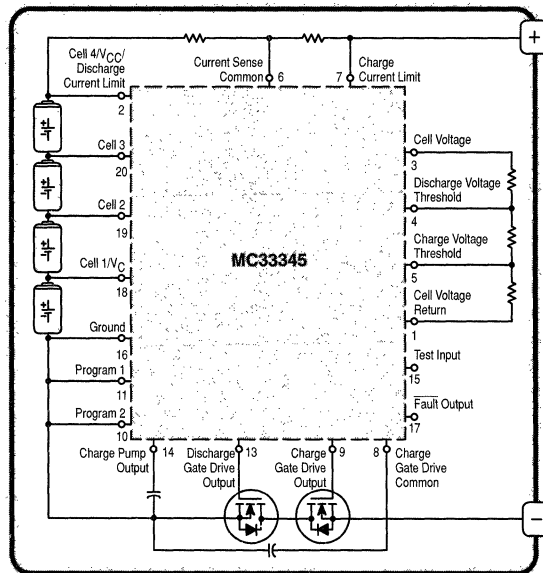
MC33345DW, DTB

$T_A = -25^\circ$  to  $+85^\circ\text{C}$ , Case 751D, 948E

The MC33345 is a monolithic lithium battery protection circuit that is designed to enhance the useful operating life of one to four cell rechargeable battery packs. Cell protection features consist of independently programmable charge and discharge limits for both voltage and current with a delayed current shutdown, cell voltage balancing with on-chip balancing resistors, and a virtually zero current sleepmode state when the cells are discharged. Additional features include an on-chip charge pump for reduced MOSFET losses while charging a low cell voltage battery pack, and the programmability for a one to four cell battery pack. This protection circuit requires a minimum number of external components and is targeted for inclusion within the battery pack. The MC33345 is available in standard and low profile 20 lead surface mount packages.

- Independently Programmable Charge and Discharge Limits for Both Voltage and Current
- Charge and Discharge Current Limit Detection with Delayed Shutdown
- Cell Voltage Balancing
- On-Chip Balancing Resistors
- Virtually Zero Current Sleepmode State when Cells are Discharged
- Charge Pump for Reduced Losses with a Low Cell Voltage Battery Pack
- Programmable for One, Two, Three or Four Cell Applications
- Minimum External Components for Inclusion within the Battery Pack
- Available in Low Profile Surface Mount Packages

Typical Four Cell Smart Battery Pack



## Battery Pack ICs (continued)

### Lithium Battery Protection Circuit for Three or Four Cell Battery Packs

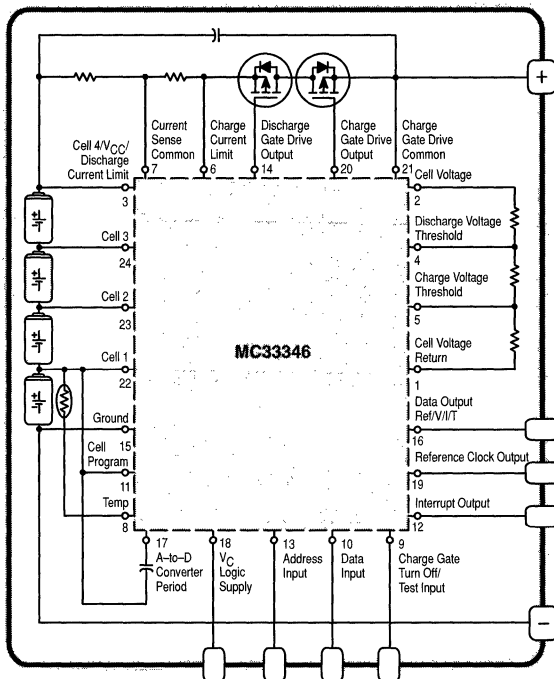
MC33346DW, DTB

$T_A = -40^\circ$  to  $+85^\circ\text{C}$ , Case 751E, 948H

The MC33346 is a monolithic lithium battery protection circuit that is designed to enhance the useful operating life of three or four cell rechargeable battery packs. Cell protection features consist of independently programmable charge and discharge limits for both voltage and current with a delayed current shutdown, cell voltage balancing with on-chip balancing resistors, and virtually zero current sleepmode state when the cells are discharged. Additional features consists of a six wire microcontroller interface bus that can selectively provide a pulse output that represents the internal reference voltage, cell voltage, cell current and temperature, as well as control the states of four internal balancing and two external MOSFET switches. A microcontroller time reference output is available for gas gauge implementation. This protection circuit requires a minimum number of external components and is targeted for inclusion within the battery pack. The MC33346 is available in standard and low profile 24 lead surface mount packages.

- Independently Programmable Charge and Discharge Limits for Both Voltage and Current
- Delayed Current Shutdown
- Cell Voltage Balancing with On-Chip Resistors
- Six Wire Microcontroller Interface Bus
- Data Output for Reference, Voltage, Current, and Temperature
- Microcontroller Time Reference Output for Gas Gauging
- Virtually Zero Current Sleepmode State when Cells are Discharged
- Programmable for Three or Four Cell Applications
- Minimum External Components for Inclusion within the Battery Pack
- Available in Low Profile Surface Mount Packages

Typical Four Cell Smart Battery Pack







## Battery Pack ICs (continued)

### Lithium Battery Protection Circuit for One Cell Battery Packs

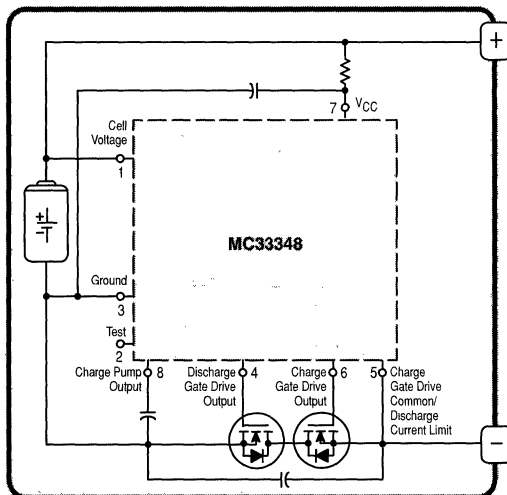
#### MC33348D, DM

$T_A = -25^\circ$  to  $+85^\circ\text{C}$ , Case 751, 846A

The MC33348 is a monolithic lithium battery protection circuit that is designed to enhance the useful operating life of one cell rechargeable battery pack. Cell protection features consist of internally trimmed charge and discharge voltage limits, discharge current limit detection with a delayed shut-down, and a virtually zero current sleepmode state when the cell is discharged. An additional feature includes an on-chip charge pump for reduced MOSFET losses while charging or discharging a low cell voltage battery pack. This protection circuit requires a minimum number of external components and is targeted for inclusion within the battery pack. This MC33348 is available in standard and micro 8 lead surface mount packages.

- Internally Trimmed Charge and Discharge Voltage Limits
- Discharge Current Limit Detection with Delayed Shutdown
- Virtually Zero Current Sleepmode State when Cells are Discharged
- Charge Pump for Reduced Losses with a Low Cell Voltage Battery Pack
- Dedicated for One Cell Applications
- Minimum Components for Inclusion within the Battery Pack
- Available in Low Profile Surface Mount Packages

Typical One Cell Smart Battery Pack



#### ORDERING INFORMATION

Device	Charge Overvoltage Threshold (V)	Charge Overvoltage Hysteresis (mV)	Discharge Undervoltage Threshold (V)	Discharge Current Limit Threshold (mV)	Operating Temperature Range	Package	
MC33348D-1	4.20	300	2.25	400	$T_A = -25^\circ$ to $+85^\circ\text{C}$	SO-8	
MC33348D-2				200			
MC33348D-3	4.25		2.28	400			
MC33348D-4				200			
MC33348D-5	4.35		2.30	400			
MC33348D-6				200			
MC33348DM-1	4.20	300	2.25	400		$T_A = -25^\circ$ to $+85^\circ\text{C}$	Micro-8
MC33348DM-2				200			
MC33348DM-3	4.25		2.28	400			
MC33348DM-4				200			
MC33348DM-5	4.35		2.30	400			
MC33348DM-6				200			

**NOTE:** Additional threshold limit options can be made available. Consult your local Motorola sales office for information.

# MOSFET/IGBT Drivers

## High Speed Dual Drivers

(Inverting)

**MC34151P, D**

$T_A = 0^\circ$  to  $+70^\circ\text{C}$ , Case 626, 751

**MC33151P, D**

$T_A = -40^\circ$  to  $+85^\circ\text{C}$ , Case 626, 751

These two series of high speed dual MOSFET driver ICs are specifically designed for applications requiring low current digital circuitry to drive large capacitive loads at high slew rates. Both series feature a unique undervoltage lockout function which puts the outputs in a defined low state in an undervoltage condition. In addition, the low "on" state resistance of these bipolar drivers allows significantly higher output currents at lower supply voltages than with competing drivers using CMOS technology.

The MC34151 series is pin-compatible with the MMH0026 and DS0026 dual MOS clock drivers, and can be used as drop-in replacements to upgrade system performance. The MC34152 noninverting series is a mirror image of the inverting MC34151 series.

These devices can enhance the drive capabilities of first generation switching regulators or systems designed with CMOS/TTL logic devices. They can be used in dc-to-dc converters, motor controllers, capacitor charge pump converters, or virtually any other application requiring high speed operation of power MOSFETs.

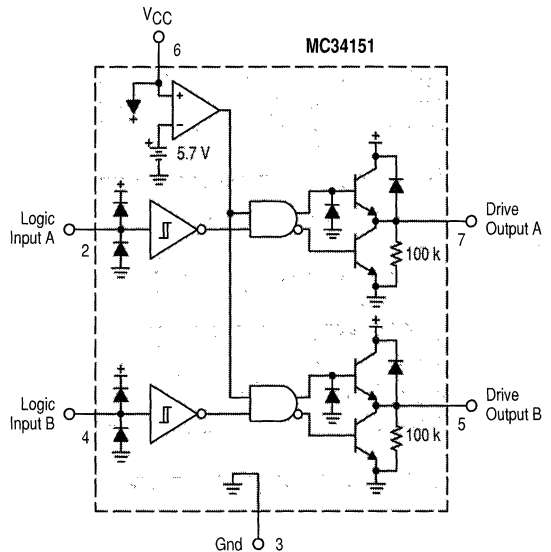
(Noninverting)

**MC34152P, D**

$T_A = 0^\circ$  to  $+70^\circ\text{C}$ , Case 626, 751

**MC33152P, D**

$T_A = -40^\circ$  to  $+85^\circ\text{C}$ , Case 626, 751



## Single IGBT Driver

**MC33153P, D**

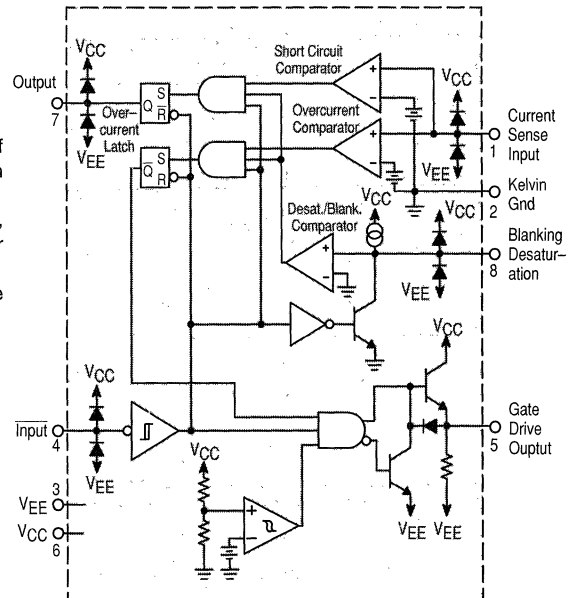
$T_A = -40^\circ$  to  $+105^\circ\text{C}$ , Case 626, 751

The MC33153 is specifically designed to drive the gate of an IGBT used for ac induction motors. It can be used with discrete IGBTs and IGBT modules up to 100 A.

Typical applications are ac induction motor control, brushless dc motor control, and uninterruptable power supplies.

These devices are available in dual-in-line and surface mount packages and include the following features:

- High Current Output Stage : 1.0 A Source – 2.0 A Sink
- Protection Circuits for Both Conventional and SenseIGBTs
- Current Source for Blanking Timing
- Protection Against Overcurrent and Short Circuit
- Undervoltage Lockout Optimized for IGBT's
- Negative Gate Drive Capability



## MOSFET/IGBT Drivers (continued)

### Single IGBT Gate Driver

#### MC33154D, P

$T_A = -40^\circ$  to  $+85^\circ\text{C}$ , Case 626, 751

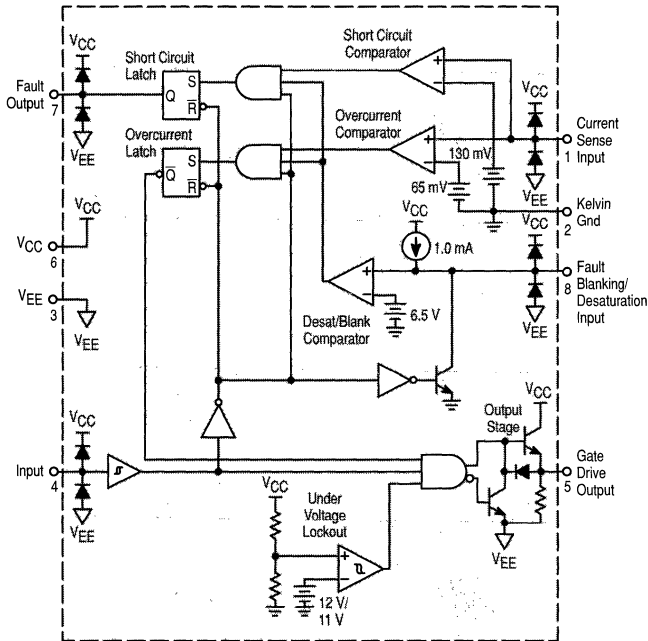
The MC33154 is specifically designed as an IGBT driver for high power applications including ac induction motor control, brushless dc motor control and uninterruptible power supplies.

The MC33154 is similar to the MC33153, except that the output drive is in-phase with the logic input, the output source current drive is four times higher and the supply voltage rating is higher.

Although designed for driving discrete and module IGBTs, this device offers a cost effective solution for driving power MOSFETs and Bipolar Transistors.

These devices are available in dual-in-line and surface mount packages and include the following features:

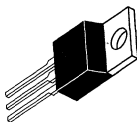
- High Current Output Stage: 4.0 A Source/2.0 A Sink
- Protection Circuits for Both Conventional and Sense IGBTs
- Programmable Fault Blanking Time
- Protection against Overcurrent and Short Circuit
- Undervoltage Lockout Optimized for IGBTs
- Negative Gate Drive Capability
- Cost Effectively Drives Power MOSFETs and Bipolar Transistors



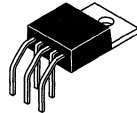
# Power Supply Circuits Package Overview



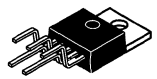
CASE 29  
P, Z SUFFIX



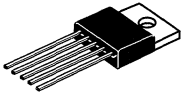
CASE 221A  
T, KC SUFFIX



CASE 314A  
TH SUFFIX



CASE 314B  
TV SUFFIX



CASE 314D  
T SUFFIX



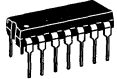
CASE 369  
DT-1 SUFFIX



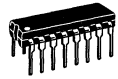
CASE 369A  
DT SUFFIX



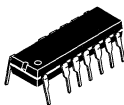
CASE 626  
N, P, P1 SUFFIX



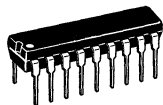
CASE 646  
P SUFFIX



CASES 648, 648C  
N, P, P2 SUFFIX



CASE 648E  
P SUFFIX



CASE 707  
N SUFFIX



CASE 751  
D, D1, D2 SUFFIX



CASE 751A  
D SUFFIX



CASE 751B  
D SUFFIX



CASE 751D  
DW SUFFIX



CASE 751E  
DW SUFFIX



CASE 751G  
DW SUFFIX



CASE 751K  
D SUFFIX



CASE 751N  
DW SUFFIX

## Power Supply Circuits Package Overview (continued)



**CASE 775**  
FN SUFFIX



**CASE 846A**  
DM SUFFIX



**CASE 873A**  
FB SUFFIX



**CASE 936**  
D2T SUFFIX



**CASE 936A**  
D2T SUFFIX



**CASE 948E**  
DTB SUFFIX



**CASE 948F**  
DTB SUFFIX



**CASE 948G**  
DTB SUFFIX



**CASE 948H**  
DTB SUFFIX



**CASE 1212**  
N SUFFIX



**CASE 1213**  
H SUFFIX



# Power/Motor Control Circuits

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## In Brief . . .

With the expansion of electronics into more and more mechanical systems, there comes an increasing demand for simple but intelligent circuits that can blend these two technologies. In the past, the task of power/motor control was once accomplished with discrete devices. But today this task is being performed by bipolar IC technology due to cost, size, and reliability constraints. Motorola offers integrated circuits designed to anticipate the requirements for both simple and sophisticated control systems, while providing cost effective solutions to meet the needs of the applications.

	<b>Page</b>
Power Controllers . . . . .	4.3-2
Zero Voltage Switch . . . . .	4.3-2
Zero Voltage Controller . . . . .	4.3-3
High-Side Driver Switch . . . . .	4.3-4
Motor Controllers . . . . .	4.3-4
Brushless DC Motor Controllers . . . . .	4.3-4
Closed Loop Brushless Motor Adapter . . . . .	4.3-7
DC Servo Motor Controller/Driver . . . . .	4.3-8
Stepper Motor Driver . . . . .	4.3-9
Universal Motor Speed Controller . . . . .	4.3-10
Package Overview . . . . .	4.3-11

# Power Controllers

An assortment of battery and ac line-operated control ICs for specific applications are shown. They are designed to enhance system performance and reduce complexity in a wide variety of control applications.

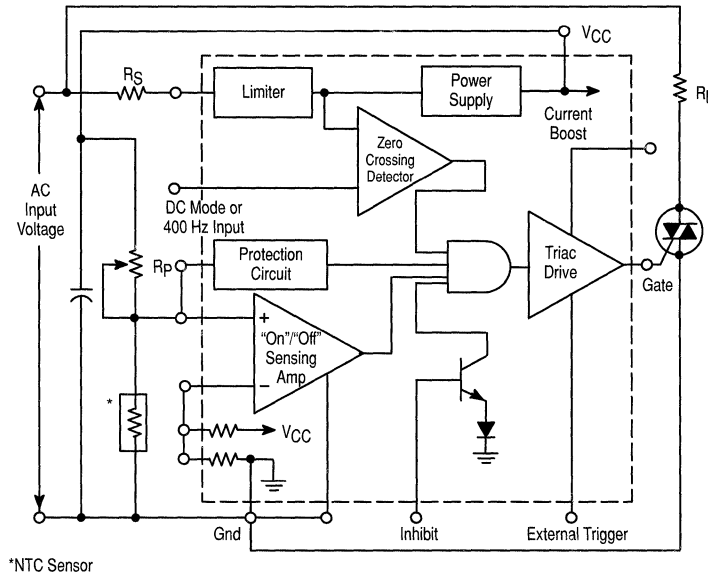
## Zero Voltage Switch

CA3059

$T_A = -40^\circ$  to  $+85^\circ\text{C}$ , Case 646

This device is designed for thyristor control in a variety of ac power switching applications for ac input voltages of 24 V, 120 V, 208/230 V, and 227 V @ 50/60 Hz.

- **Limiter-Power Supply** – Allows operation directly from an ac line.
- **Differential “On”/“Off” Sensing Amplifier** – Tests for condition of external sensors or input command signals. Proportional control capability or hysteresis may be implemented.
- **Zero-Crossing Detector** – Synchronizes the output pulses to the zero voltage point of the ac cycle. Eliminates RFI when used with resistive loads.
- **Triac Drive** – Supplies high current pulses to the external power controlling thyristor.
- **Protection Circuit** – A built-in circuit may be actuated, if the sensor opens or shorts, to remove the drive circuit from the external triac.
- **Inhibit Capability** – Thyristor firing may be inhibited by the action of an internal diode gate.
- **High Power DC Comparator Operation** – Operation in this mode is accomplished by connecting Pin 7 to 12 (thus overriding the action of the zero-crossing detector).





## Power Controllers (continued)

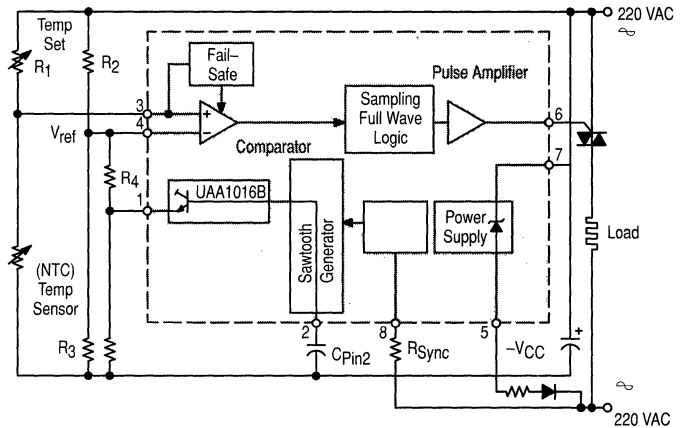
### Zero Voltage Controller

#### UAA1016B

$T_A = -20^\circ$  to  $+100^\circ\text{C}$ , Case 626

The UAA1016B is designed to drive triacs with the Zero voltage technique which allows RFI free power regulation of resistive loads. It provides the following features:

- Proportional Temperature Control Over an Adjustable Band
- Adjustable Burst Frequency (to Comply with Standards)
- No DC Current Component Through the Main Line (to Comply with Standards)
- Negative Output Current Pulses (Triac Quadrants 2 and 3)
- Direct AC Line Operation
- Low External Components Count



### Zero Voltage Controller

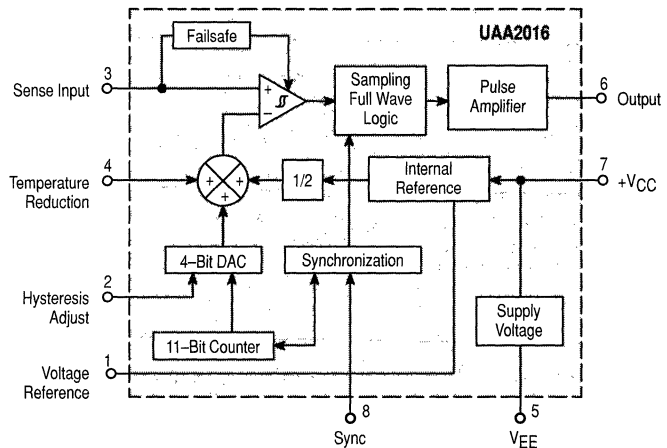
#### UAA2016P, D

$T_A = -20^\circ$  to  $+85^\circ\text{C}$ , Case 626, 751

The UAA2016 is designed to drive triacs with the Zero Voltage technique which allows RFI free power regulation of resistive loads. Operating directly on the ac power line, its main application is the precision regulation of electrical heating systems such as panel heaters or irons.

A built-in digital sawtooth waveform permits proportional temperature regulation action over a  $\pm 1^\circ\text{C}$  band around the set point. For energy savings there is a programmable temperature reduction function, and for security, a sensor failsafe inhibits output pulses when the sensor connection is broken. Preset temperature (i.e., defrost) application is also possible. In applications where high hysteresis is needed, its value can be adjusted up to  $5^\circ\text{C}$  around the set point. All these features are implemented with a very low external component count.

- Zero Voltage Switch for Triacs, up to 2.0 kW (MAC212A8)
- Direct AC Line Operation
- Proportional Regulation of Temperature over a  $1^\circ\text{C}$  Band
- Programmable Temperature Reduction
- Preset Temperature (i.e., Defrost)
- Sensor Failsafe
- Adjustable Hysteresis
- Low External Component Count



## Power Controllers (continued)

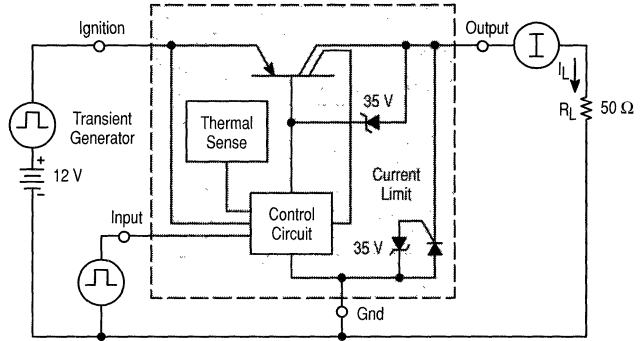
### High-Side Driver Switch

#### MC3399T, DW

$T_J = -40^\circ$  to  $+150^\circ\text{C}$ , Case 314D, 751G

The MC3399T is a high side driver switch that is designed to drive loads from the positive side of the power supply. The output is controlled by a TTL compatible Enable pin. In the "on" state, the device exhibits very low saturation voltages for load currents in excess of 750 mA. The device also protects the load from positive or negative-going high voltage transients by becoming an open circuit and isolating the transient for its duration from the load.

The MC3399T is fabricated on a Power BiMOS process which combines the best features of Bipolar and MOS technologies. The mixed technology provides higher gain PNP output devices and results in Power Integrated Circuits with reduced quiescent current.



## Motor Controllers

This section contains integrated circuits designed for cost effective control of specific motor families. Included are controllers for brushless, dc servo, stepper, and universal type motors.

### Brushless DC Motor Controllers

Advances in magnetic materials technology and integrated circuits have contributed to the unprecedented rise in popularity of brushless dc motors. Analog control ICs are making the many features and advantages of brushless motors available at a much more economical price. Motorola offers a family of monolithic integrated brushless dc motor

controllers. These ICs provide a choice of control functions which allow many system features to be easily implemented at a fraction of the cost of discrete solutions. The following table summarizes and compares the features of Motorola's brushless motor controllers.

**Table 1. Features Summary for Motorola Brushless DC Motor Controllers**

Device	Operating Voltage Range (V)		Undervoltage Lockout	Internal Thermal Shutdown	Fwd/Rev Control	Sensor Electrical Phasing	Output Enable	Output Drivers			6.25 V Reference Output	Current Sense Comparator Input(s)	Error Amplifier	FAULT Output	Separate Drive VC	Brake Input	Suffix/Package
	V <sub>CC</sub>	V <sub>C</sub>						Totem Pole (Bottom)	Open Collector (Top)								
MC33033	10-30	-	✓	✓	✓	60°/300° and 120°/240°	✓	✓	✓	✓	Noninv. Only	✓	-	-	-	P/738, DW/751D	
MC33035	10-40	10-30	✓	✓	✓	120°/240°	✓	✓	✓	✓	Noninv. and Inv.	✓	✓	✓	✓	P/724, DW/751E	

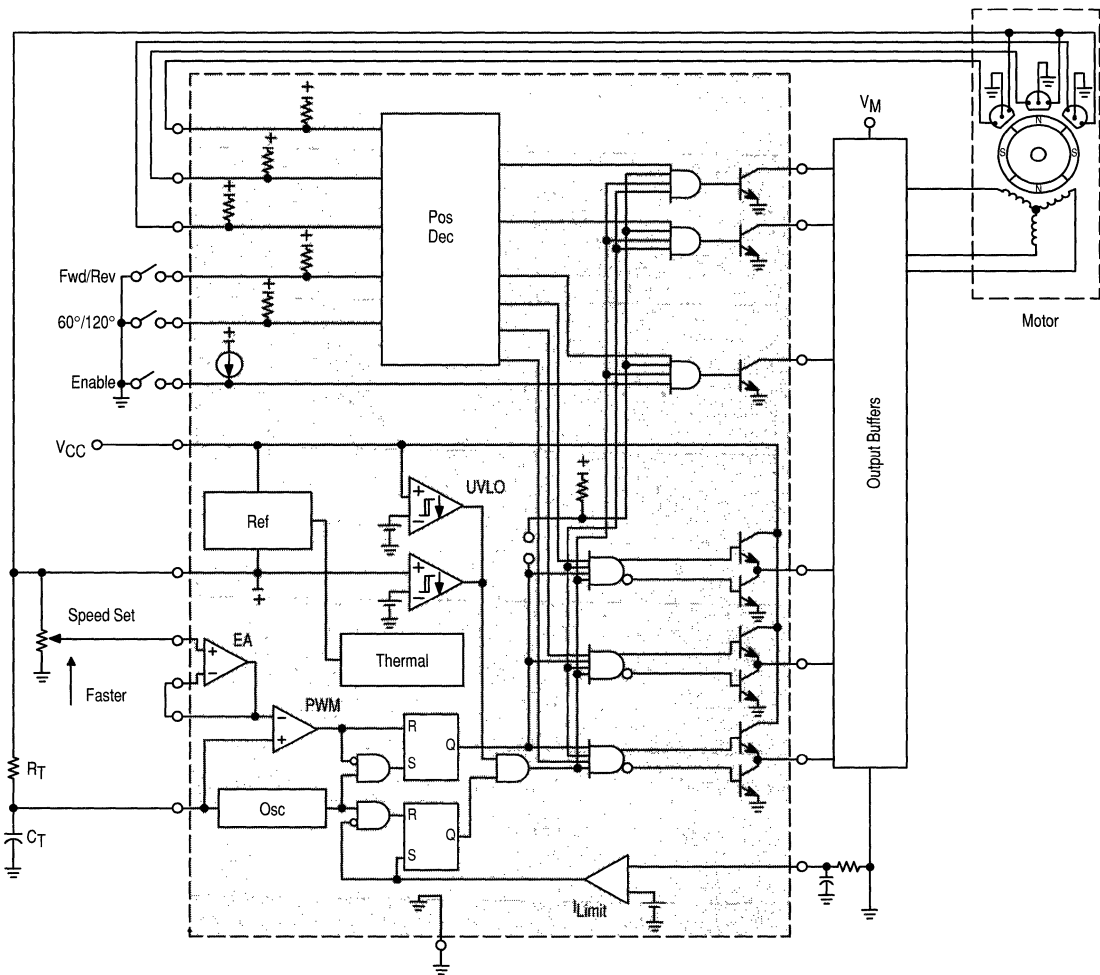
## Motor Controllers (continued)

### MC33033P, DW

$T_A = -40^\circ$  to  $+85^\circ\text{C}$ , Case 738, 751D

The MC33033 is a lower cost second generation brushless dc motor controller which has evolved from the full featured MC33035 controller. The MC33033 contains all of the active functions needed to implement a low cost open loop motor control system. This IC has all of the key control and protection functions of the two full featured devices with the following secondary features deleted: separate drive-circuit supply and ground pins, the brake input, and the fault output signal. Like its MC33035 predecessor, the MC33033 has a control pin which allows the user to select  $60^\circ/300^\circ$  or  $120^\circ/240^\circ$  sensor electrical phasings.

Because of its low cost, the MC33033 can efficiently be used to control brush dc motors as well as brushless. A brush dc motor can be driven using two of the three drive output phases provided in the MC33033, while the Hall sensor input pins are selectively tied to  $V_{Ref}$  or ground. Other features such as forward/reverse, output enable, speed control, current limiting, undervoltage lockout and internal thermal shutdown will still remain functional.



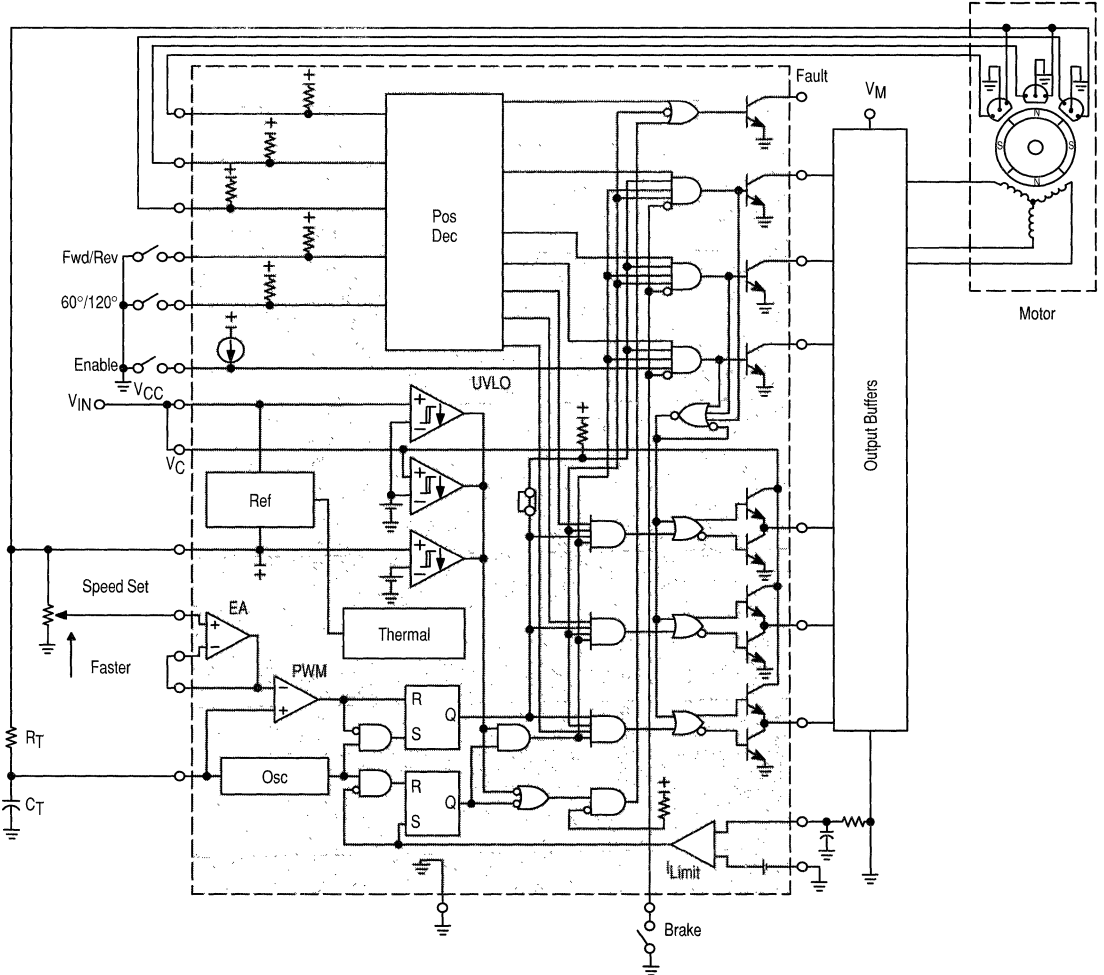
## Motor Controllers (continued)

### MC33035P, DW

$T_A = -40^\circ$  to  $+85^\circ\text{C}$ , Case 724, 751E

The MC33035 is a second generation high performance brushless dc motor controller which contains all of the active functions required to implement a full featured open loop motor control system. While being pin-compatible with an earlier device, the MC33035 offers additional features at a lower price. The two additional features provided by the MC33035 are a pin which allows the user to select  $60^\circ/300^\circ$

or  $120^\circ/240^\circ$  sensor electrical phasings, and access to both inverting and noninverting inputs of the current sense comparator. The earlier devices had two part numbers which were needed to support the different sensor phasings, and the inverting input to the current sense comparator was internally grounded. All of the control and protection features of the earlier device are also provided in the MC33035.



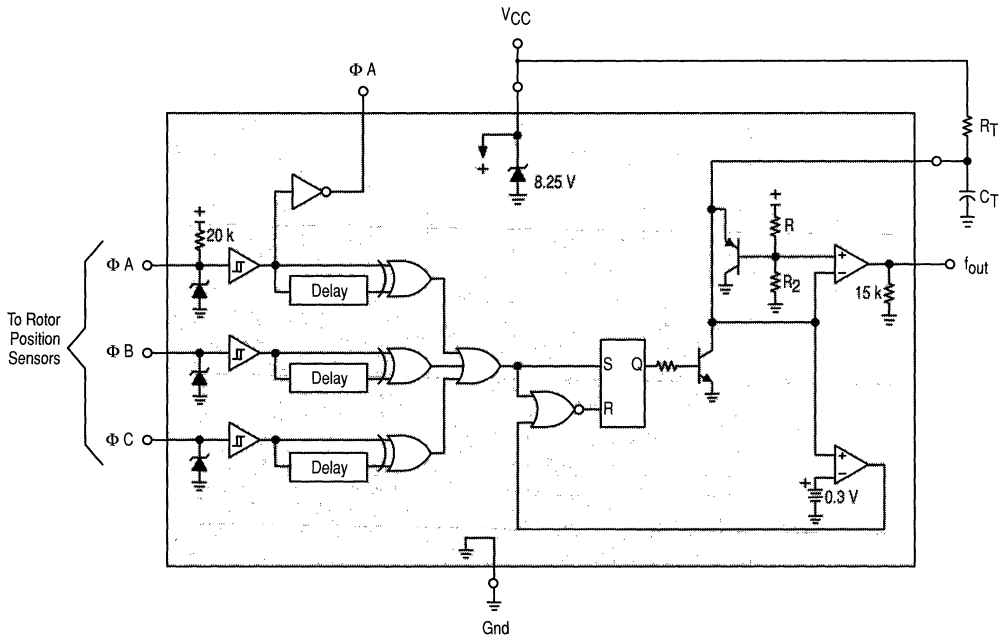
## Closed Loop Brushless Motor Adapter

MC33039P, D

$T_A = -40^\circ$  to  $+85^\circ\text{C}$ , Case 626, 751

The MC33039 is a high performance close loop speed control adapter specifically designed for use in brushless dc motor control systems. Implementation will allow precise speed regulation without the need for a magnetic or optical tachometer. These devices contain three input buffers each with hysteresis for noise immunity, three digital edge

detectors, a programmable monostable, and an internal shunt regulator. Also included is an inverter output for use in systems that require conversion of sensor phasing. Although this device is primarily intended for use with the MC33033/35 brushless motor controllers, it can be used cost effectively in many other closed loop speed control applications.



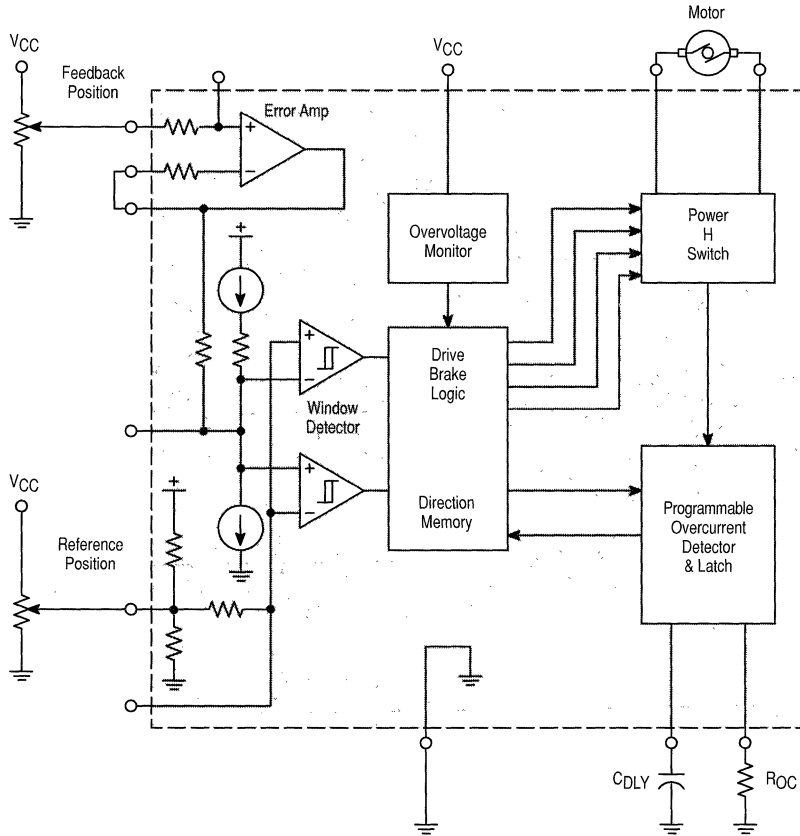
## DC Servo Motor Controller/Driver

MC33030P, DW

$T_A = -40^\circ$  to  $+85^\circ\text{C}$ , Case 648C, 751G

A monolithic dc servo motor controller providing all active functions necessary for a complete closed loop system. This device consists of an on-chip op amp and window comparator with wide input common mode range, drive and brake logic with direction memory, a power H switch driver capable of

1.0 A, independently programmable over current monitor and shutdown delay, and over voltage monitor. This part is ideally suited for almost any servo positioning application that requires sensing of temperature, pressure, light, magnetic flux, or any other means that can be converted to a voltage.



## Motor Controllers (continued)

### Stepper Motor Driver

MC3479P, FN

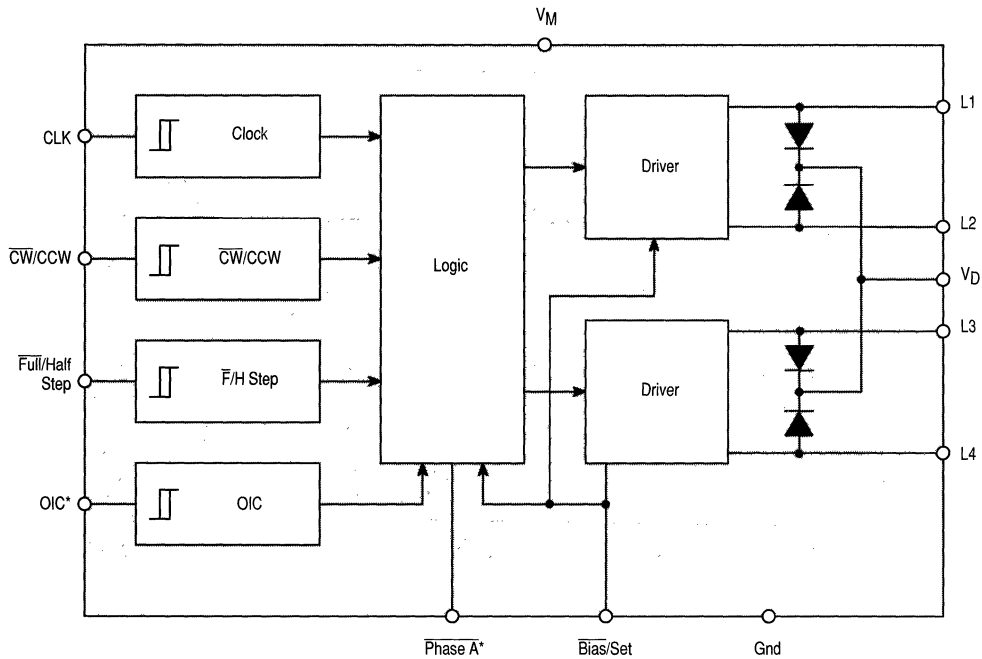
$T_A = 0^\circ$  to  $+70^\circ\text{C}$ , Case 648C, 775

SAA1042V

$T_A = -30^\circ$  to  $+125^\circ\text{C}$ , Case 648C

These Stepper Motor Drivers provide up to 500 mA of drive per coil for two phase 6.0 V to 24 V stepper motors. Control logic is provided to accept commands for clockwise, counter

clockwise and half or full step operation. The MC3479 has an added Output Impedance Control (OIC) and a Phase A drive state indicator (not available on SAA1042 devices).



\* MC3479 Only

## Motor Controllers (continued)

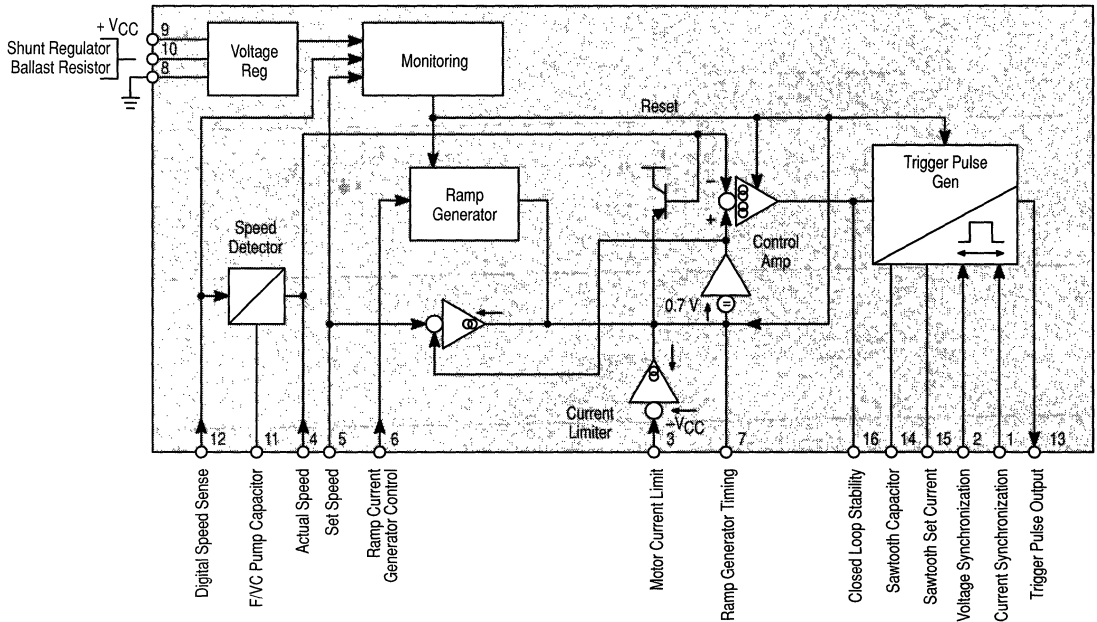
# Universal Motor Speed Controller

TDA1085C, CD

$T_A = -10^\circ$  to  $+120^\circ\text{C}$ , Case 648, 751B

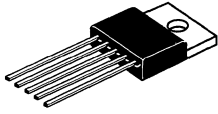
The TDA1085C is a phase angle triac controller having all the necessary functions for universal motor speed control in washing machines. It operates in closed loop configuration and provides two ramp possibilities.

- On-Chip Frequency to Voltage Converter
- On-Chip Ramps Generator
- Soft Start
- Load Current Limitation
- Tachogenerator Circuit Sensing
- Direct Supply from AC Line
- Security Functions Performed by Monitor





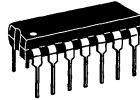
# Power/Motor Control Circuits Package Overview



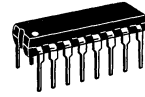
CASE 314D  
T SUFFIX



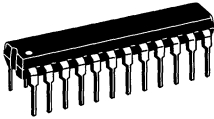
CASE 626  
B, P SUFFIX



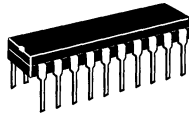
CASE 646



CASE 648, 648C  
P, V SUFFIX



CASE 724  
P SUFFIX



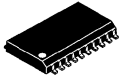
CASE 738  
P SUFFIX



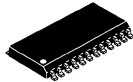
CASE 751  
D SUFFIX



CASE 751B  
D SUFFIX



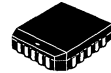
CASE 751D  
DW SUFFIX



CASE 751E  
DW SUFFIX



CASE 751G  
DW SUFFIX



CASE 775  
FN SUFFIX



# Voltage References

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## In Brief . . .

Motorola's line of precision voltage references is designed for applications requiring high initial accuracy, low temperature drift, and long term stability. Initial accuracies of  $\pm 1.0\%$ , and  $\pm 2.0\%$  mean production line adjustments can be eliminated. Temperature coefficients of 25 ppm/ $^{\circ}\text{C}$  max (typically 10 ppm/ $^{\circ}\text{C}$ ) provide excellent stability. Uses for the references include D/A converters, A/D converters, precision power supplies, voltmeter systems, temperature monitors, and many others.

	<b>Page</b>
Precision Low Voltage References . . . . .	4.4-2
Package Overview . . . . .	4.4-2

# Precision Low Voltage References

A family of precision low voltage bandgap reference devices designed for applications requiring low temperature drift.

**Table 1. Precision Low Voltage References**

V <sub>out</sub> (V) Typ	I <sub>O</sub> (mA) Max	V <sub>out</sub> /T ppm/°C Max	Device		Regline (mV) Max	Regload (mV) Max	Package
			0° to +70°C	-40° to +85°C			
1.235 ± 12 mV 1.235 ± 25 mV	20	80 Typ	LM385BZ-1.2 LM385Z-1.2	LM285Z-1.2	(Note 1)	1.0 (Note 2)	Z, D
2.5 ± 38 mV 2.5 ± 75 mV			LM385BZ-2.5 LM385Z-2.5	LM285Z-2.5		2.0 (Note 3)	
2.5 ± 25 mV	10	25	MC1403A	-	3.0/4.5 (Note 4)	10 (Note 5)	D
		40	MC1403	-			
5.0 ± 50 mV	10	40	MC1404P5	-	6.0 (Note 6)		P
6.25 ± 60 mV		40	MC1404P6	-			
10 ± 100 mV		40	MC1404P10	-			
2.5 to 37	100	50 Typ	TL431C, AC, BC	TL431I, AI, BI	Shunt Reference Dynamic Impedance (z) ≤ 0.5 Ω		LP, P, D, DM

Notes: 1. Micropower Reference Diode Dynamic Impedance (z) ≤ 1.0 Ω at I<sub>R</sub> = 100 μA.

2. 10 μA ≤ I<sub>R</sub> ≤ 1.0 mA.

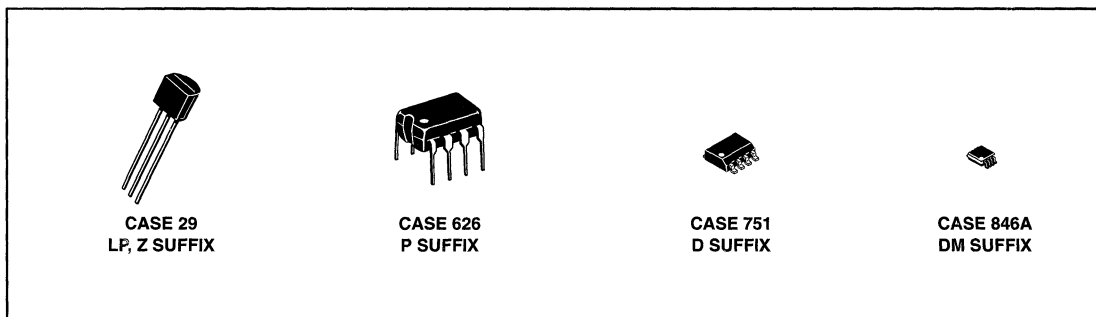
3. 20 μA ≤ I<sub>R</sub> ≤ 1.0 mA.

4. 4.5 V ≤ V<sub>in</sub> ≤ 15 V/15 V ≤ V<sub>in</sub> ≤ 40 V.

5. 0 mA ≤ I<sub>L</sub> ≤ 10 mA.

6. (V<sub>out</sub> + 2.5 V) ≤ V<sub>in</sub> ≤ 40 V.

## Voltage References Package Overview



# Data Conversion

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## In Brief . . .

Motorola's line of digital-to-analog and analog-to-digital converters include several varieties to suit a number of applications.

The A/D converters include an 8-bit flash converter suitable for NTSC and PAL systems. CMOS devices include 8 to 10-bit converters, as well as other high speed digitizers.

The D/A converters have 6 and 8-bit devices, and video speed (for NTSC and PAL) devices.

	<b>Page</b>
Data Conversion . . . . .	4.5-2
A-D Converters . . . . .	4.5-2
CMOS . . . . .	4.5-2
Bipolar . . . . .	4.5-2
Sigma-Delta . . . . .	4.5-2
D-A Converters . . . . .	4.5-3
CMOS . . . . .	4.5-3
Sigma-Delta . . . . .	4.5-3
Package Overview . . . . .	4.5-4

# Data Conversion

The line of data conversion products which Motorola offers spans a wide spectrum of speed and resolution/accuracy. Features, including bus compatibility, minimize external parts count and provide easy interface to microprocessor systems. Various technologies, such as Bipolar and CMOS, are utilized

to achieve functional capability, accuracy and production repeatability. Bipolar technology generally results in higher speed, while CMOS devices offer greatly reduced power consumption.

**Table 1. A-D Converters**

Resolution (Bits)	Device	Nonlinearity Max	Conversion Time/Rate	Input Voltage Range	Supplies (V)	Temperature Range (°C)	Suffix/Package	Comments
<b>CMOS</b>								
8	MC145040	±1/2 LSB	10 μs	0 to V <sub>DD</sub>	+5.0 ±10%	-40 to +125	P/738, DW/751D	Requires External Clock, 11-Ch MUX
	MC145041		20 μs					Includes Internal Clock, 11-Ch MUX
	MC14549B/ MC14559B	Successive Approximation Registers		+3.0 to +18	-40 to +85	P/648	Compatible with MC1408 S.A.R. 8-bit D-A Converter	
Triple 8-Bit	MC44251	1 LSB	18 MHz	1.6 to 4.6 V	+5.0 ±10%	-40 to +85	FN/777, FU/824A	3 Separate Video Channels
10	MC145050	±1 LSB	21 μs	0 to V <sub>DD</sub>	+5.0 ±10%	-40 to +125	P/738, DW/751D	Requires External Clock, 11-Ch MUX
	MC145051		44 μs					Includes Internal Clock, 11-Ch MUX
	MC145053						P/646, D/751A	Includes Internal Clock, 5-Ch MUX
8-10	MC14443/ MC14447	±0.5% Full Scale	300 μs	Variable w/Supply	+5.0 to +18	-40 to +85	P/648, DW/751G	μP Compatible, Single Slope, 6-Ch MUX
3-1/2 Digit	MC14433	±0.05% ±1 Count	40 ms	±2.0 V ±200 mV	+5.0 to +8.0 -2.8 to -8.0		P/709, DW/751E	Dual Slope
<b>Bipolar</b>								
8	MC10319	±1 LSB	25 MHz	0 to 2.0 V <sub>pp</sub> Max	+5.0 and -3.0 to -6.0	0 to +70	P/709, DW/751F Die Form	Video Speed Flash Converter, Internal Gray Code TTL Outputs
<b>Sigma-Delta</b>								
16	MC145073	±1 LSB	48 kHz	1.9 V <sub>pp</sub>	4.5 to 5.5	-40 to +85	DW/751E	Dual Channel, Sigma-Delta architecture

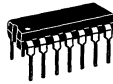
**Table 2. D–A Converters**

Resolution (Bits)	Device	Accuracy @ 25°C Max	Max Settling Time ( $\pm 1/2$ LSB)	Supplies (V)	Temperature Range (°C)	Suffix/Package	Comments
<b>CMOS</b>							
6	MC144110	–	–	+5.0 to +15	0 to +85	P/707, DW/751D	Serial input, Hex DAC, 6 outputs
	MC144111	–	–			P/646, DW/751G	Serial input, Quad DAC, 4 outputs
	MC144112	–	–	+2.5 to +5.5	–40 to +85	P/646, D/751A	Serial input, Quad DAC, 4 outputs
Triple 8–Bit	MC44200	$\pm 1/2$ LSB	30 ns	+5.0 $\pm 10\%$	–40 to +85	FU/824A	Triple Video DAC, 55 MHz, TTL

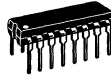
**Sigma–Delta**

16, 18, 20	MC145074	See data sheet	6.0 ns	4.5 to 5.5	–40 to +85	D/751B	Dual Channel, Sigma–Delta architecture, MC145076 FIR Filter available
–	MC145076	See data sheet	–	+5.0	–40 to +85	D/751B	Dual Channel Bit Stream, 144 tap FIR Filter

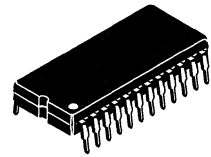
# Data Conversion Package Overview



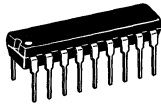
CASE 646  
P SUFFIX



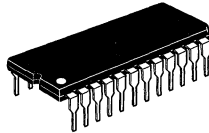
CASE 648  
P SUFFIX



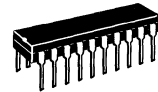
CASE 649  
P SUFFIX



CASE 707  
P SUFFIX



CASE 709  
P SUFFIX



CASE 738  
P SUFFIX



CASE 751A  
D SUFFIX



CASE 751B  
D SUFFIX



CASE 751D  
DW SUFFIX



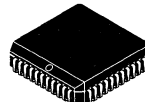
CASE 751E  
DW SUFFIX



CASE 751F  
DW SUFFIX



CASE 751G  
DW SUFFIX



CASE 777  
FN SUFFIX



CASE 824A  
FU SUFFIX



# Interface Circuits

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## In Brief . . .

Described in this section is Motorola's line of interface circuits, which provide the means for interfacing with microprocessor or digital systems and the external world, or to other systems.

Also included are devices which allow a microprocessor to communicate with its own array of memory and peripheral I/O circuits.

The line drivers, receivers, and transceivers permit communication between systems over cables of several thousand feet in length, and at data rates of up to several megahertz. The common EIA data transmission standards, several European standards, and IEEE-488 are addressed by these devices.

The peripheral drivers are designed to handle high current loads such as relay coils, lamps, stepper motors, and others. Input levels to these drivers can be TTL, CMOS, high voltage MOS, or other user defined levels. The display drivers are designed for LCD or LED displays, and provide various forms of decoding.

	<b>Page</b>
Enhanced Ethernet Transceiver . . . . .	4.6-2
ISO 8802-3[IEEE 802.3] 10BASE-T Transceiver . . .	4.6-3
Hex EIA-485 Transceiver with Three-State Outputs . . . . .	4.6-4
5.0 V, 200 M-Bit/Sec PR-IV Hard Disk Drive Read Channel . . . . .	4.6-5
Line Receivers . . . . .	4.6-7
EIA Standard . . . . .	4.6-7
Line Drivers . . . . .	4.6-7
EIA Standard . . . . .	4.6-7
Line Transceivers . . . . .	4.6-7
EIA-232-E/V.28 CMOS Drivers/Receivers . . . . .	4.6-7
Peripheral Drivers . . . . .	4.6-8
IEEE 802.3 Transceivers . . . . .	4.6-8
Read/Write Channel . . . . .	4.6-8
Drive Read Channel . . . . .	4.6-8
Inkjet Drivers . . . . .	4.6-8
28-Channel Inkjet Driver . . . . .	4.6-8
CMOS Display Drivers . . . . .	4.6-9
Package Overview . . . . .	4.6-10

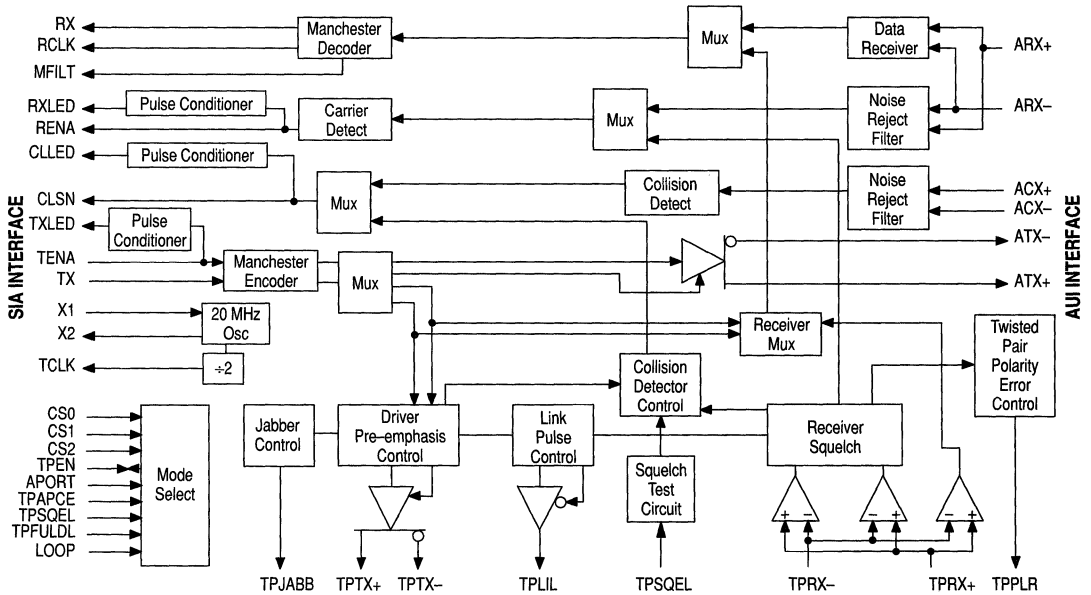
# Enhanced Ethernet Transceiver

## MC68160FB

T<sub>A</sub> = 0° to +70°C, Case 848D

The MC68160 Enhanced Ethernet Interface Circuit is a BiCMOS device which supports both IEEE 802.3 Access Unit Interface (AUI) and 10BASE-T Twisted Pair (TP) Interface media connections through external isolation transformers. It encodes NRZ data to Manchester data and supplies the signals which are required for data communication via 10BASE-T or AUI interfaces. The MC68160 gluelessly

interfaces to the Ethernet controller contained in the MC68360 Quad Integrated Communications Controller (QUICC) device. The MC68160 also interfaces easily to most other industry-standard IEEE 802.3 LAN controllers. Prior to twisted pair data reception, Smart Squelch circuitry qualifies input signals for correct amplitude, pulse width, and sequence requirements.



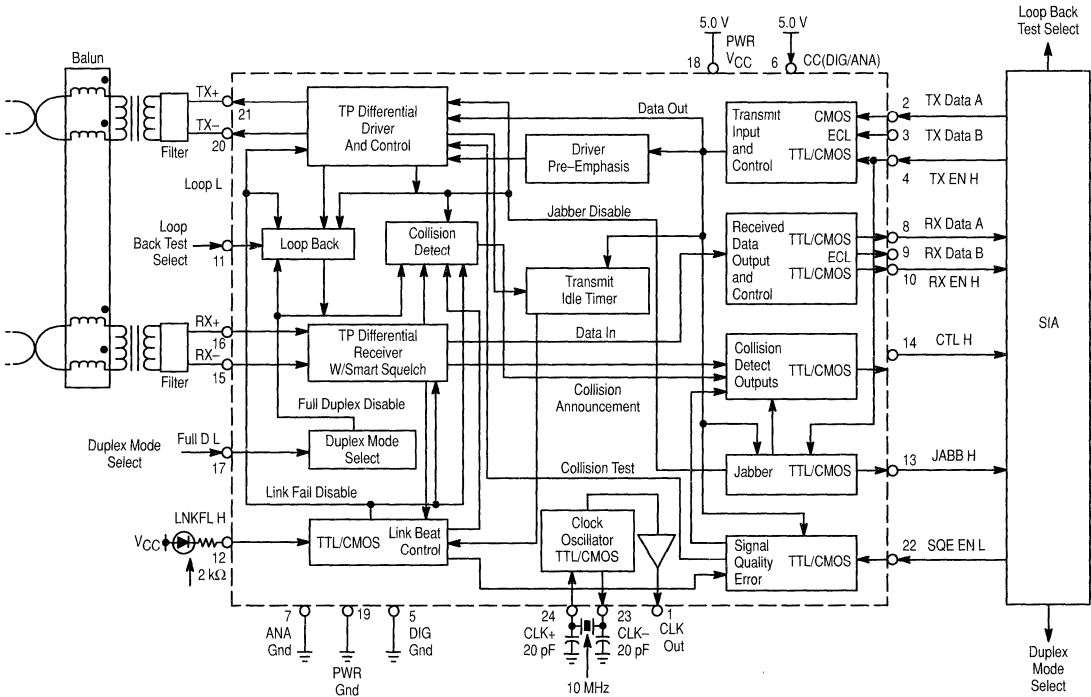
# ISO 8802-3[IEEE 802.3] 10BASE-T Transceiver

MC34055DW

T<sub>A</sub> = 0° to +70°C, Case 751E

The Motorola 10BASE-T transceiver, designed to comply with the ISO 8802-3[IEEE 802.3] 10BASE-T specification, will support a Medium Dependent Interface (MDI) in an embedded Media Attachment Unit (MAU). The interface supporting the Data Terminal Equipment (DTE) is TTL, CMOS, and raised ECL compatible, and the interface to the

Twisted Pair (TP) media is supported through standard 10BASE-T filters and transformers. Differential data intended for the TP media is provided a 50 ns pre-emphasis and data at the TP receiver, is screened by Smart Squelch circuitry for specific threshold, pulse width, and sequence requirements.



# Hex EIA-485 Transceiver with Three-State Outputs

## MC34058/59FTA

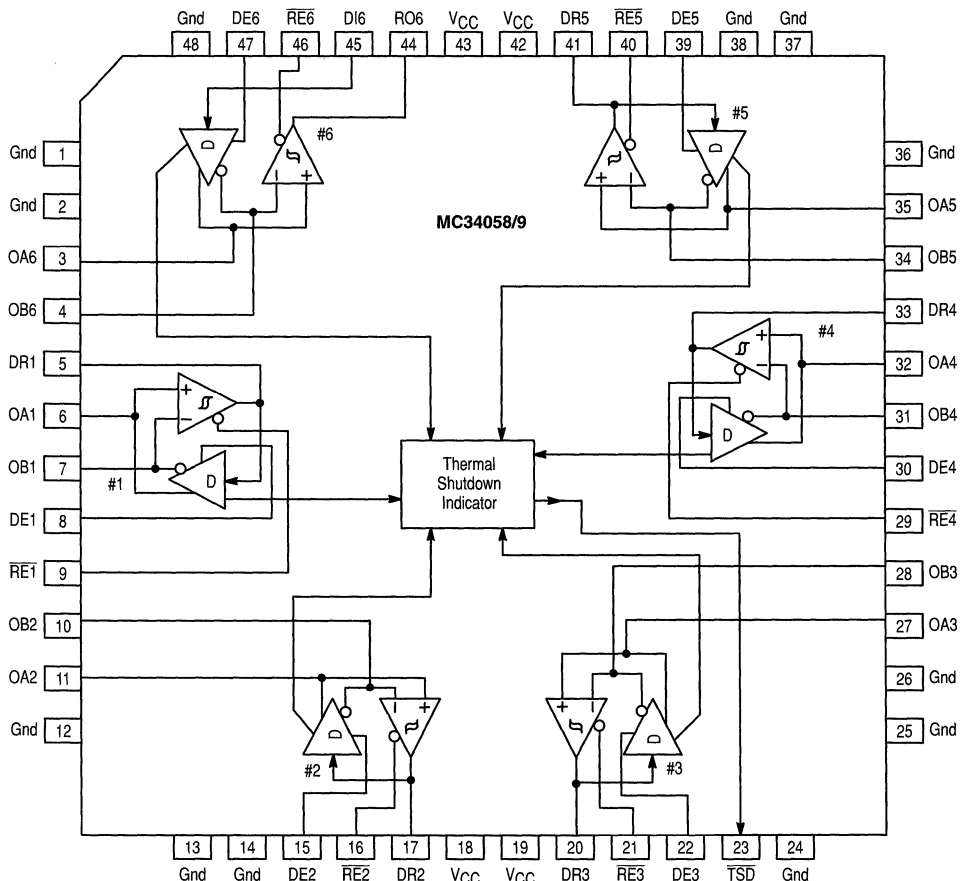
$T_A = 0^\circ$  to  $+70^\circ\text{C}$ , Case 932

The Motorola MC34058/9 Hex Transceiver is composed of six driver/receiver combinations designed to comply with the EIA-485 standard. Features include three-state outputs, thermal shutdown for each driver, and current limiting in both directions. This device also complies with EIA-422 and CCITT Recommendations V.11 and X.27.

The devices are optimized for balanced multipoint bus transmission at rates to 20 MBPS (MC34059). The driver outputs/receiver inputs feature a wide common mode voltage range, allowing for their use in noisy environments. The current limit and thermal shutdown features protect the devices from line fault conditions.

The MC34058/9 is available in a space saving 7.0 mm 48 lead surface mount quad package designed for optimal heat dissipation.

- Meets EIA-485 Standard for Party Line Operation
- Meets EIA-422A and CCITT Recommendations V.11 and X.27
- Operating Ambient Temperature:  $0^\circ\text{C}$  to  $+70^\circ\text{C}$
- Common Mode Driver Output/Receiver Input Range:  $-7.0$  to  $+12\text{ V}$
- Positive and Negative Current Limiting
- Transmission Rates to 14 MBPS (MC34058) and 20 MBPS (MC34059)
- Driver Thermal Shutdown at  $150^\circ\text{C}$  Junction Temperature
- Thermal Shutdown Active Low Output
- Single  $+5.0\text{ V}$  Supply,  $\pm 10\%$
- Low Supply Current
- Compact 7.0 mm 48 Lead TQFP Plastic Package
- Skew Specified for MC34059



## 5.0 V, 200 M–Bit/Sec PR–IV Hard Disk Drive Read Channel

### MC34250FTA

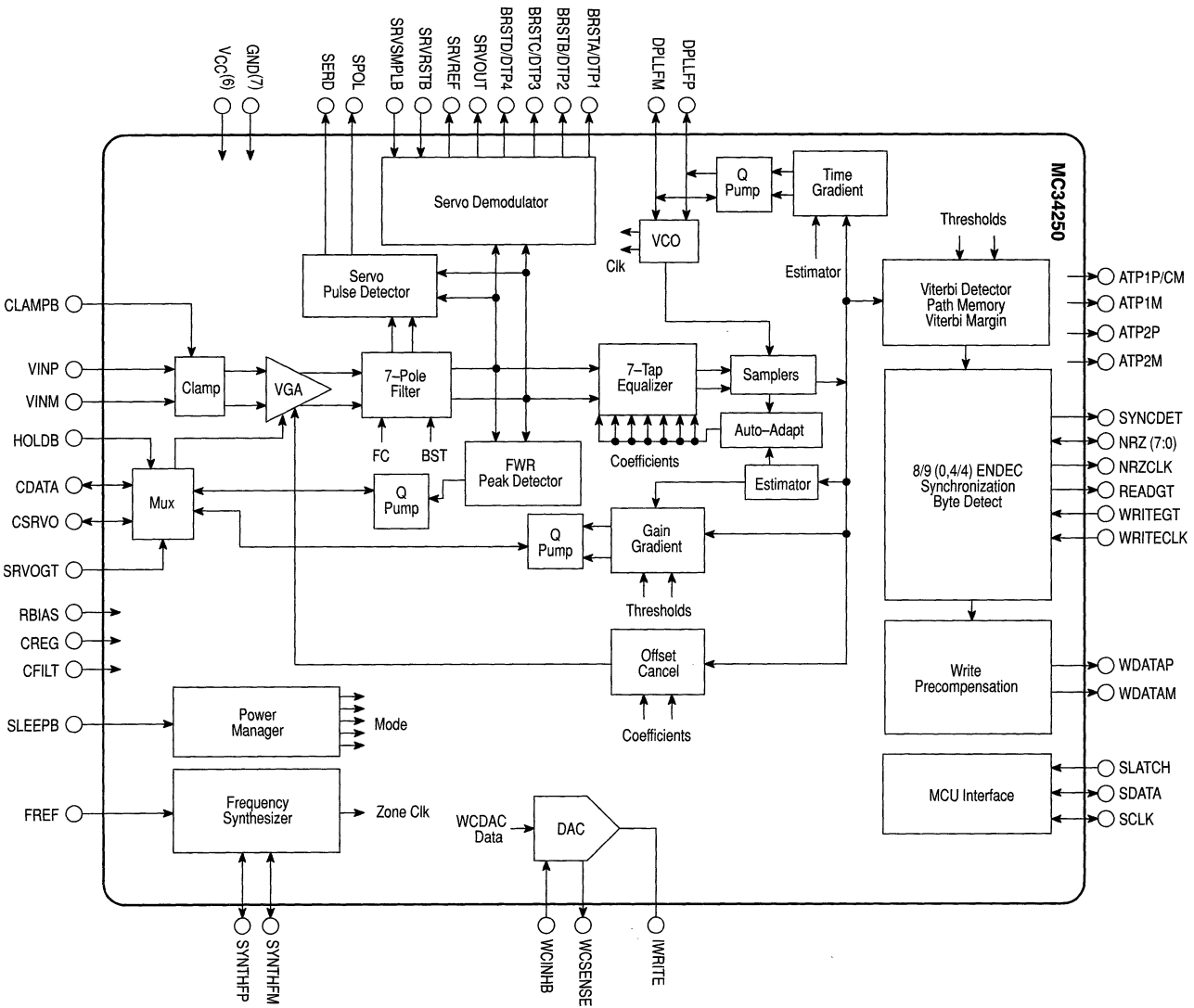
$T_A = 0^\circ$  to  $+70^\circ\text{C}$ , Case 840F

The Motorola MC34250 is a fully integrated partial response maximum likelihood disk drive read/write channel for use in zoned recording applications. This device integrates the AGC, active filter, 7 tap equalizer, Viterbi detector, frequency synthesizer, servo demodulator, 8/9 rate (0,4/4) Encoder/Decoder with write precompensation and power management in a single 64 pin 10 mm x 10 mm TQFP package.

#### FEATURES:

- 50 to 200 MBPS Programmable Data Rate
- 800 mW at 200 MBPS and 5.0 V
- Channel Monitor Output
- Programmable AGC Charge Pump Currents with Different Values for Data and Servo Envelope Modes and Gain Gradient Mode
- Programmable AGC Peak Detector Droop Currents with Different Values for Data and Servo Envelope Modes
- Separate AGC Charge Pump Outputs for Data and Servo Modes
- Programmable Dual Threshold Qualifier or Hysteresis Comparator Type Pulse Detector for Servo Data Detection.
- ERD and Polarity Outputs for Servo Timing and Raw Encoded Data
- Integrated 7 pole 0.05° Equiripple Linear Phase Filter with Programmable Bandwidth from 5.0 MHz to 80 MHz and Different Values for Both Data and Servo Modes
- Programmable Symmetrical Boost from 0 to 10 dB and Different Values for Data and Servo Modes
- Programmable Asymmetrical Boost of Up to  $\pm 40\%$  of Nominal Filter Group Delay in Both Data and Servo Modes
- 7 Tap Continuous Time Transversal Equalizer with 8 Bit Programmable Tap Weights and Integrated Decision Directed Sign–Sign Least Mean Squared Adaptation
- Internal Offset Cancellation Loops
- Fast Acquisition Data Phase Locked Loop with Zero Phase Restart
- Programmable Data Phase Locked Loop Charge Pump Current
- Integrated Soft Decision Viterbi Detectors with Programmable Merge References
- Integrated 8/9 Rate (0,4/4) Encoder and Decoder with Code Scrambler and Descrambler
- Programmable 2/4/8 Bit NRZ Data Interface
- Programmable Write Precompensation Delays Locked to the Frequency Synthesizer
- Differential PECL Write Data Outputs
- External Write Data Path for DC Erase or Other Non–Encoded Data
- Integrated Write Current DAC
- Programmable Power Management
- Bi–Directional Serial Microprocessor Interface
- Various Test Modes Controlled Via the Serial Microprocessor Interface

5.0 V, 200 M-Bit/Sec PR-IV Hard Disk Drive Read Channel (continued)



# Line Receivers

**Table 1. EIA Standard**

S = Single Ended D = Differential	Type of Output	t <sub>prop</sub> Delay Time Max (ns)	Party Line Operation	Strobe or Enable	Power Supplies (V)	Device	Suffix/Package	Receivers Per Package	Companion Drivers	Comments
S	TP	4000	–	–	+5.0	MC14C89B, AB	P/646, D/751A	4	MC1488 MC14C88B	EIA-232-D/ EIA-562
	R <sup>(1)</sup>	85	–	–		MC1489 MC1489A				EIA-232-D

(1) R = Resistor Pull-up, TP = Totem-pole output.

# Line Drivers

**Table 2. EIA Standard**

Output Current Capability (mA)	t <sub>prop</sub> Delay Time Max (ns)	S = Single Ended D = Differential	Party Line Operation	Strobe or Enable	Power Supplies (V)	Device	Suffix/Package	Drivers Per Package	Companion Receivers	Comments	
85	35	D	✓	✓	+5.0	MC75174B MC75172B	P/648	4	–	EIA-485	
15	3500	S	–		±7.0 to ±12	MC14C88B	P/646, D/751A		–	MC14C89B MC14C89AB	EIA-232-D/ EIA-562
10	350				±9.0 to ±12	MC1488			MC1489 MC1489A	EIA-232-D	
60	300	S/D	–	EIA-422 ✓ EIA-423 –	±5.0	AM26LS30 MC26LS30	PC/648 D/751B	2 (422) 4 (423)	–	EIA-422 or EIA-423 Switchable	

**Table 3. Line Transceivers**

Driver Prop Delay (Max ns)	Receiver Prop Delay (Max ns)	DE = Driver Enable RE = Receiver Enable	Party Line Operation	Power Supplies (V)	Device	Suffix/Package	Drivers Per Package	Receivers Per Package	EIA Standard
23	23	DE, RE	✓	+5.0	MC34058	FTA/932	6	6	EIA-485 to 14 MBPS
					MC34059	FTA/932	6	6	EIA-485 to 20 MBPS

**Table 4. EIA-232-E/V.28 CMOS Drivers/Receivers**

Device	Suffix/Package	Pins	Drivers	Receivers	Power Supplies (V)	Features
MC145403	P/738, DW/751D	20	3	5	±5.0 to ±12	
MC145404			4	4		
MC145405			5	3		
MC145406	P/648, DW/751G, SD/940B	16	3			
MC145407	P/738, DW/751D	20			+5.0	Charge Pump
MC145408	P/724, DW/751E, SD/940B	24	5	5	±5.0 to ±12	

**Table 4. EIA-232-E/V.28 CMOS Drivers/Receivers (continued)**

Device	Suffix/ Package	Pins	Drivers	Receivers	Power Supplies (V)	Features
MC145583	DW/751F, VF/940J	28	3	5	+3.3 to +5.0	On-board ring monitor circuit; charge pump, power down
MC145705	P/738, DW/751D	20	2	3	+5.0	Charge Pump, Power Down
MC145706			3	2		
MC145707	P/724, DW/751E	24		3		

**Table 5. Peripheral Drivers**

Output Current Capability (mA)	Input Capability	Propagation Delay Time Max ( $\mu$ s)	Output Clamp Diode	Off State Voltage Max (V)	Device	Drivers Per Package	Suffix/ Package	Logic Function
500	TTL, CMOS	1.0	✓	50	ULN2803	8	A/707	Invert
	6.0 V to 15 V MOS				ULN2804			
	TTL, 5.0 V CMOS				MC1413, B (ULN2003A)	7	P/648, D/751B	
	8.0 V to 18 V MOS				MC1416, B (ULN2004A)			

**Table 6. IEEE 802.3 Transceivers**

Device	Power Supply	10 BaseT	NRZ	IEEE	Comments	Suffix/ Package
MC34055	+5.0 Vdc	Transmit and Receive over 4 Pins	Raised ECL, CMOS	802.3 Type 10BaseT	Transceiver with non-return to zero (NRZ) interface. Intended for but not restricted to concentrators and repeater applications.	DW/751E
MC68160			TTL, CMOS	802.3 Type 10BaseT/ AUI/NRZ	Interfaces gluelessly to Motorola's MC68360 communications controller.	FB/848D

## Read/Write Channel

**Table 7. Hard Disk Drive Read Channel**

Device	Power Supply	Comments	T <sub>A</sub> (°C)	Suffix/ Package
MC34250	5.0 V	200 Mbps fully integrated partial response maximum likelihood hard disk drive read/write channel which equalizes to a PR-IV shape and uses 8/9 rate (0, 4/4) coding.	0 to +70	FTA/840F

## Inkjet Drivers

**Table 8. 28-Channel Inkjet Driver**

Device	Power Supply	Comments	T <sub>A</sub> (°C)	Suffix/ Package
MC34156	5.0 V	A 4 to 14 line decoder determines the selected output driver in each of two 14 driver banks. Two independent output enable lines permit 1 or 2 of 28 outputs. Outputs are open collector 30 V Darlington drivers capable of sinking 500 mA.	0 to +70	FN/777



# CMOS Display Drivers

These CMOS devices include digit as well as matrix drivers for LEDs, LCDs, and VFDs. They find applications over a wide

range of end equipment such as instruments, automotive dashboards, home computers, appliances, radios and clocks.

**Table 9. Display Drivers**

Display Type	Input Format	Drive Capability Per Package	On-Chip Latch	Display Control	Segment Drive Current	Device
LCD (Direct Drive)	Parallel BCD	7 Segments	✓	Blank	≈ 1.0 mA	MC14543B
				Blank, Ripple Blank		MC14544B
Muxed LCD (1/4 Mux)	Serial Binary [Compatible with the Serial Peripheral Interface (SPI) on CMOS MCUs]	33 Segments or Dots	✓		20 μA	MC145453
		48 Segments or Dots			≈ 200 μA	MC145000
		44 Segments or Dots				MC145001
LED, Incandescent, Fluorescent <sup>(1)</sup>	Parallel BCD	7 Segments	-	Blank, Lamp Test	25 mA	MC14511B
				Blank, Ripple Blank, Lamp Test		MC14513B
					65 mA	MC14547B
Muxed LED (1/4 Mux)	Serial Binary [Compatible with the Serial Peripheral Interface (SPI) on CMOS MCUs]	4 Digits + Decimals	✓	Oscillator (Scanner)	50 mA (Peak)	MC14499
Muxed LED (1/5 Mux)		5 Characters + Decimals or 25 Lamps		Oscillator (Scanner), Low Power Mode, Dimming	0 to 35 mA (Peak) Adjustable	MC14489
LED (Direct Drive)		Parallel Hex		7 Segments + A thru F Indicator		10 mA <sup>(2)</sup>
(Interfaces to Display Drivers)	Parallel BCD	7 Segments	-	Ripple Blank, Enable	-	MC14558B

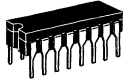
<sup>(1)</sup> Absolute maximum working voltage = 18 V.

<sup>(2)</sup> On-chip current-limiting resistor.

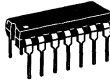
**Table 10. Functions**

Device	Function	Package
MC14489	Multi-Character LED Display/Lamp Driver	738, 751D
MC14495-1	Hexadecimal-to-7 Segment Latch/Decoder ROM/Driver	648, 751G
MC14499	4-Digit 7-Segment LED Display Decoder/Driver with Serial Interface	707, 751D
MC14511B	BCD-to-7-Segment Latch/Decoder/Driver	648, 751G
MC14513B	BCD-to-7-Segment Latch/Decoder/Driver with Ripple Blanking	726, 707
MC14543B	BCD-to-7-Segment Latch/Decoder/Driver for Liquid Crystals	620, 648
MC14544B	BCD-to-7-Segment Latch/Decoder/Driver with Ripple Blanking	726, 707
MC14547B	High-Current BCD-to-7-Segment Decoder/Driver	620, 648
MC14558B	BCD-to-7-Segment Decoder	620, 648
MC145000	48-Segment Serial Input Multiplexed LCD Driver (Master)	709, 776
MC145001	44-Segment Serial Input Multiplexed LCD Driver (Slave)	707, 776
MC145453	33-Segment, Non-Multiplexed LCD Driver with Serial Interface	711, 777

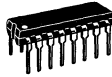
# Interface Circuits Package Overview



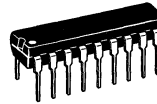
CASE 620



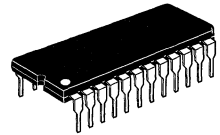
CASE 646  
P SUFFIX



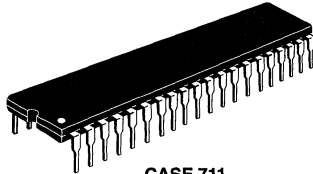
CASE 648  
P, PC SUFFIX



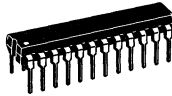
CASE 707  
A SUFFIX



CASE 709  
P SUFFIX



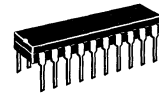
CASE 711  
P SUFFIX



CASE 724  
P SUFFIX



CASE 726



CASE 738  
P SUFFIX



CASE 751A  
D SUFFIX



CASE 751B  
D SUFFIX



CASE 751D  
DW SUFFIX



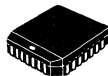
CASE 751E  
DW SUFFIX



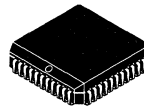
CASE 751F  
DW SUFFIX



CASE 751G  
DW SUFFIX



CASE 776  
FN SUFFIX



CASE 777  
FN SUFFIX



CASE 840F  
FTA SUFFIX



CASE 848D  
FB SUFFIX



CASE 932  
FTA SUFFIX



CASE 940B  
SD SUFFIX



CASE 940J  
VF SUFFIX

# Communication Circuits

## In Brief . . .

### RF

Radio communication has greatly expanded its scope in the past several years. Once dominated by public safety radio, the 30 to 1000 MHz spectrum is now packed with personal and low cost business radio systems. The vast majority of this equipment uses FM or FSK modulation and is targeted at short range applications. From mobile phones and VHF marine radios to garage door openers and radio controlled toys, these new systems have become a part of our lifestyle. Motorola Analog has focused on this technology, adding a wide array of new products including complete receivers processed in our exclusive 3.0 GHz MOSAIC® 1.5 process. New surface mount packages for high density assembly are available for all of these products, as well as a growing family of supporting application notes and development kits.

### Telephone & Voice/Data

Traditionally, an office environment has utilized two distinctly separate wired communications systems: telecommunications and data communications. Each had its individual hardware components complement, and each required its own independent transmission line system: twisted wire pairs for Telecom and relatively high priced coaxial cable for Datacom. But times have changed. Today, Telecom and Datacom coexist comfortably on inexpensive twisted wire pairs and use a significant number of components in common. This has led to the development and enhancement of PBX (Private Branch Exchanges) to the point where the long heralded "office of the future," with simultaneous voice and data communications capability at each station, is no longer of the future at all. The capability is here today!

Motorola Semiconductor serves a wide range of requirements for the voice/data marketplace. We offer both CMOS and Analog technologies, each to its best advantage, to upgrade the conventional analog voice systems and establish new capabilities in digital communications. Early products, such as the solid-state single-chip crosspoint switch, the more recent monolithic Subscriber-Loop-Interface Circuit (SLIC), a single-chip Codec/Filter (Mono-Circuit), the Universal Digital Loop Transceivers (UDLT), basic rate ISDN (Integrated Services Digital Network), and single-chip telephone circuits are just a few examples of Motorola leadership in the voice/data area.

	<b>Page</b>
RF Communications	4.7-2
RF Front End ICs	4.7-2
Wideband IFs	4.7-2
Wideband Single Conversion Receivers	4.7-2
Narrowband Single Conversion Receivers	4.7-2
Narrowband Dual Conversion Receivers	4.7-3
Universal Cordless Phone Subsystem ICs	4.7-3
Transmitters	4.7-3
Balanced Modulator/Demodulator	4.7-4
Infrared Transceiver	4.7-4
Telecommunications	4.7-11
Subscriber Loop Interface Circuit	4.7-11
PBX Architecture (Analog Transmission)	4.7-12
PCM Monocircuits	4.7-12
Dual Tone Multiple Frequency Receiver	4.7-15
ISDN Voice/Data Circuits	4.7-15
Integrated Services Digital Network	4.7-15
Second Generation U-Interface Transceivers	4.7-16
Second Generation S/T-Interface Transceivers	4.7-16
Dual Data Link Controller	4.7-17
Voice/Data Communication (Digital Transmission)	4.7-18
Universal Digital Loop Transceiver	4.7-18
ISDN Universal Digital Loop Transceiver II	4.7-19
Electronic Telephone Circuit	4.7-19
Tone Ringers	4.7-20
Speech Networks	4.7-21
Speakerphones	4.7-25
Voice Switched Speakerphone Circuit	4.7-25
Voice Switched Speakerphone with	
μProcessor Interface	4.7-27
Voice Switched Speakerphone Circuit	4.7-28
Telephone Line Interface and Speakerphone Circuit	4.7-29
Family of Speakerphone ICs	4.7-30
Telephone Accessory Circuits	4.7-31
Audio Amplifier	4.7-31
Current Mode Switching Regulator	4.7-31
300 Baud FSK Modems	4.7-32
ADPCM Transcoder	4.7-32
Calling Line Identification (CLID) Receiver	4.7-33
CVSD Modulator/Demodulator	4.7-34
Summary of Bipolar Telecommunications Circuits	4.7-35
Phase-Locked Loop Components	4.7-38
PLL Frequency Synthesizers	4.7-38
Phase-Locked Loop Functions	4.7-39
Package Overview	4.7-41

# RF Communications

**Table 1. RF Front End ICs**

Device	Low Noise Amplifier				Mixer				Voltage Cont Osc	V <sub>CC</sub> (V)	I <sub>CC</sub> (mA)	Suffix/Package
	Gain (dB)	Noise Figure (dB)	IIP3 (dBm)	P1dB (dBm)	Gain (dB)	Noise Figure (dB)	IIP3 (dBm)	P1dB (dBm)				
MC13141	17	1.8	-5	-15	7	16	-3 to +15	-10	-	2.7 to 6.5	7.7	D1/751, D/751A, FTB/976
MC13142	17	1.8	-5	-15	±3	12	-3 to +21	3	Yes	2.7 to 6.5	13	D/751B, FTB/976
MC13143	-	-	-	-	±3	12	-3 to +21	3	-	1.8 to 6.5	1	D/751
MC13144	13 to 19	1.4	-1	-7	-	-	-	-	-	1.8 to 6.5	2 to 9	D/751

**NOTES:** All devices operate over a wide range of RF input and IF frequencies, from dc to 2.0 GHz. Typical performance shown at 900 MHz.

**Table 2. Wideband (FM/FSK) IFs**

Device	V <sub>CC</sub>	I <sub>CC</sub>	Sensitivity (Typ)	IF	Mute	RSSI	Max Data Rate	Notes	Suffix/Package
MC13055	3-12 V	25 mA	20 µV	40 MHz	✓	✓	2.0 Mb	Wideband Data IF, includes data shaper	P/648, D/751B
MC13155	3-6 V	7.0 mA	100 µV	250 MHz	-	-	10 Mb	Video Speed FM IF	D/751B

**Table 3. Wideband Single Conversion Receivers – VHF**

Device	V <sub>CC</sub>	I <sub>CC</sub>	Sensitivity (Typ)	RF Input	IF	Mute	RSSI	Max Data Rate	Notes	Suffix/Package
MC3356	3-9 V	25 mA	30 µV	200MHz	10.7MHz	✓	✓	500 kb	Includes front end mixer/L.O.	P/738, DW/751D
MC13156	2-6 V	5.0 mA	2.0 µV	500 MHz	21.4MHz	-	-	>1.2 Mb	CT-2 FM/Demodulator	DW/751E, FB/873
MC13158	2-6 V	6.0 mA	600 MHz	600 MHz	-	-	-		FM IF/Demodulator with split IF for DECT	FTB/873
MC13159	2.7-5 V	5.5 mA						500 kb	FM IF for PHS	DTB/948F

**Table 4. Narrowband Single Conversion Receivers – VHF**

Device	V <sub>CC</sub>	I <sub>CC</sub>	12 dB SINAD Sensitivity (Typ)	RF Input	IF	Mute	RSSI	Max Data Rate	Notes	Suffix/Package
MC3357	4-8 V	5.0 mA	5.0 µV	45 MHz	455 kHz	✓	-	>4.8 kb	Ceramic Quad Detector/Resonator	P/648, D/751B
MC3359	4-9 V	7.0 mA	2.0 µV	60 MHz	60 MHz	-	-	>4.8 kb	Scan output option	P/707, DW/751D
MC3371	2-8 V	6.0 mA	60 MHz						60 MHz	-
MC3372	2-8 V	6.0 mA		60 MHz	60 MHz	-	-	>4.8 kb		
MC13150	3-6 V	1.8 mA	1.0 µV						500 MHz	500 MHz

## RF Communications (continued)

**Table 5. Narrowband Dual Conversion Receivers – FM/FSK – VHF**

Device	V <sub>CC</sub>	I <sub>CC</sub>	12 dB SINAD Sensitivity (Typ)	RF Input	IF1	IF2 (Limiter In)	Mute	RSSI	Data Rate	Notes	Suffix/Package
MC3362	2–7 V	3.0 mA	0.7 μV	180 MHz	10.7 MHz	455 kHz	–	✓	> 4.8 kb	Includes buffered VCO output	P/724, DW/751E
MC3363		4.0 mA	0.4 μV				✓	Includes RF amp/mute		DW/751F	
MC3335		0.7 μV	Low cost version				DW/751D, P/738				
MC13135		1.0 μV	Voltage buffered RSSI, LC Quad Detector				DW/751E, P/724				
MC13136		Voltage Buffered RSSI, Ceramic Quad Detector									

**Table 6. Universal Cordless Phone Subsystem ICs**

Device	V <sub>CC</sub>	I <sub>CC</sub>	Dual Conversion Receiver	Universal Dual PLL	Compander and Audio Interface	Voice Scrambler	Low Battery Detect	Programmable R <sub>x</sub> , T <sub>x</sub> Trim Gain and LBD Voltage Reference	Suffix/Package
MC13109	2.0–5.5 V	Active Mode 6.7 mA Inactive Mode 40 μA	✓	✓	✓	–	1	–	FB/848B, FTA/932
MC13110	2.7–5.5 V	Active Mode 8.2 mA Inactive Mode 60 μA	✓	✓	✓	✓	2	✓	FB/848B
MC13111	2.7–5.5 V	Active Mode 8.2 mA Inactive Mode 60 μA	✓	✓	✓	–	2	✓	FB/848B

**Table 7. Transmitters – AM/FM/FSK**

Device	V <sub>CC</sub>	I <sub>CC</sub>	P <sub>out</sub>	Max RF Freq Out	Max Mod Freq	Notes	Suffix/Package
MC2833	3–8 V	10 mA	–30 dBm to +10 dBm	150 MHz	50 kHz	FM transmitter. Includes two frequency multiplier/amplifier transistors	P/648, D/751B
MC13175	2–5 V	40 mA	8.0 dBm	500 MHz	5.0 MHz	AM/FM transmitter. Single frequency PLL $f_{out} = 8 \times f_{ref}$ , includes power down function	D/751B
MC13176				1.0 GHz		$f_{out} = 32 \times f_{ref}$ , includes power down function	

**Table 8. Balanced Modulator/Demodulator**

Device	V <sub>CC</sub>	I <sub>CC</sub>	Function	Suffix/ Package
MC1496	3–5 V	10 mA	General purpose balanced modulator/demodulator for AM, SSB, FM detection with Carrier Balance >50 dB	P/646, D/751A

**Table 9. Infrared Transceiver**

Device	V <sub>CC</sub>	I <sub>CC</sub>	12 dB SINAD Sensitivity (Typ)	Max IF Freq	Carr Det	RSSI	Data Rate	Notes	Suffix/ Package
MC13173	3–5 V	6.5 mA	5.0 μV	10.7 MHz	✓	✓	200 kb	Includes Single Frequency PLL for T <sub>X</sub> Carrier and R <sub>X</sub> LO	FTB/873

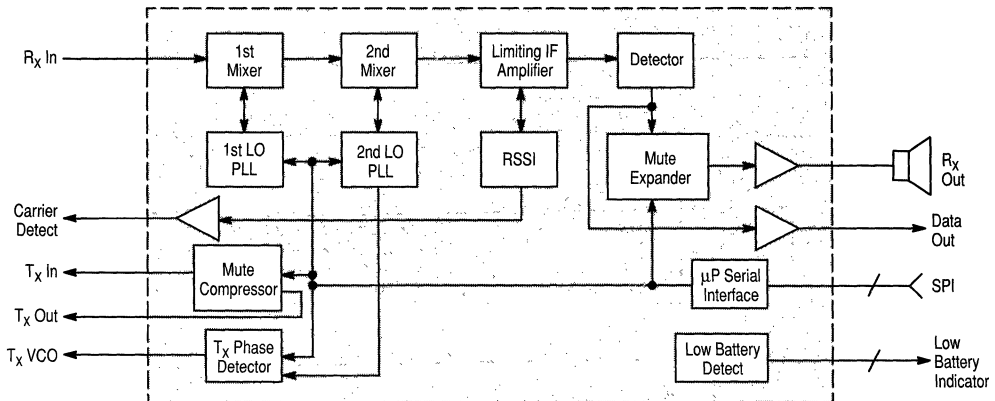
## Universal Cordless Telephone Subsystem IC

### MC13109FB, FTA

T<sub>A</sub> = –20° to +85°C, Case 848B, 932

The MC13109 integrates several of the functions required for a cordless telephone into a single integrated circuit. This significantly reduces component count, board space requirements, and external adjustments. It is designed for use in both the handset and the base.

- Dual Conversion FM Receiver
  - Complete Dual Conversion Receiver – Antenna Input to Audio Output 80 MHz Maximum Carrier Frequency
  - RSSI Output
  - Carrier Detect Output with Programmable Threshold
  - Comparator for Data Recovery
  - Operates with Either a Quad Coil or Ceramic Discriminator
- Compander
  - Expander Includes Mute, Digital Volume Control and Speaker Driver
  - Compressor Includes Mute, ALC and Limiter
- Dual Universal Programmable PLL
  - Supports New 25 Channel U.S. Standard with No External Switches
  - Universal Design for Domestic and Foreign CT–1 Standards
  - Digitally Controlled Via a Serial Interface Port
  - Receive Side Includes 1st LO VCO, Phase Detector, and 14–Bit Programmable Counter and 2nd LO with 12–Bit Counter
  - Transmit Section Contains Phase Detector and 14–Bit Counter
  - MPU Clock Output Eliminates Need for MPU Crystal
- Supply Voltage Monitor
  - Externally Adjustable Trip Point
- 2.0 to 5.5 V Operation with One–Third the Power Consumption of Competing Devices



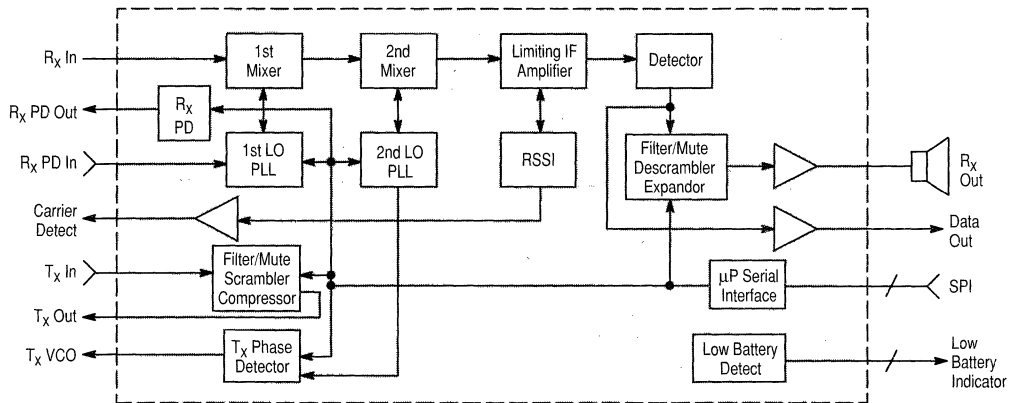
# Universal Cordless Telephone Subsystem IC with Scrambler

## MC13110FB

$T_A = -40^\circ$  to  $+85^\circ\text{C}$ , Case 848B

The MC13110 integrates several of the functions required for a cordless telephone into a single integrated circuit. This significantly reduces component count, board space requirements, and external adjustments. It is designed for use in both the handset and the base.

- Dual Conversion FM Receiver
  - Complete Dual Conversion Receiver – Antenna In to Audio Out 80 MHz Maximum Carrier Frequency
  - RSSI Output
  - Carrier Detect Output with Programmable Threshold
  - Comparator for Data Recovery
  - Operates with Either a Quad Coil or Ceramic Discriminator
- Compaander
  - Expander Includes Mute, Digital Volume Control, Speaker Driver, 3.5 kHz Low Pass Filter, and Programmable Gain Block
  - Compressor Includes Mute, 3.5 kHz Low Pass Filter, Limiter, and Programmable Gain Block
- Dual Universal Programmable PLL
  - Supports New 25 Channel U.S. Standard with New External Switches
  - Universal Design for Domestic and Foreign CT-1 Standards
  - Digitally Controlled Via a Serial Interface Port
  - Receive Side Includes 1st LO VCO, Phase Detector, and 14–Bit Programmable Counter and 2nd LO with 12–Bit Counter
  - Transmit Section Contains Phase Detector and 14–Bit Counter
  - MPU Clock Outputs Eliminates Need for MPU Crystal
- Supply Voltage Monitor
  - Provides Two Levels of Monitoring with Separate Outputs
  - Separate, Adjustable Trip Points
- Frequency Inversion Scrambler/Descrambler
  - Can Be Enabled/Disabled Via MPU Interface
  - Programmable Carrier Modulation Frequency
- 2.7 to 5.5 V Operation with One–Third the Power Consumption of Competing Devices



# Narrowband FM Receiver

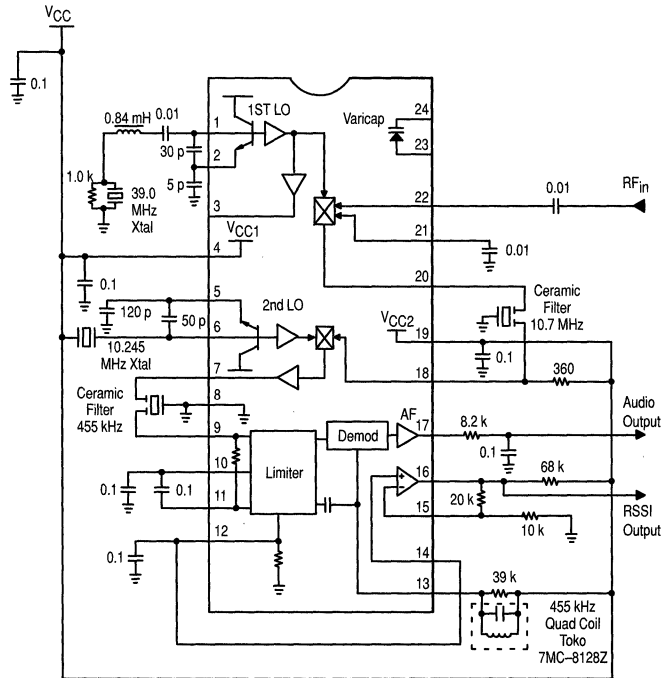
MC13135/136P, DW

T<sub>A</sub> = -40° to +85°C, Case 724, 751E

The MC13135 is a full dual conversion receiver with oscillators, mixers, Limiting IF Amplifier, Quadrature Discriminator, and RSSI circuitry. It is designed for use in security systems, cordless phones, and VHF mobile and portable radios. Its wide operating supply voltage range and low current make it ideal for battery applications. The Received Signal Strength Indicator (RSSI) has 65 dB of dynamic range with a voltage output, and an operational amplifier is included for a dc buffered output. Also, an

improved mixer third order intercept enables the MC13135 to accommodate larger input signal levels.

- Complete Dual Conversion Circuitry
- Low Voltage: 2.0 to 6.0 Vdc
- RSSI with Op Amp: 65 dB Range
- Low Drain Current: 3.5 mA Typical
- Improved First and Second Mixer 3rd Order Intercept
- Detector Output Impedance: 25 Ω Typically









# Wideband FM IF Subsystem

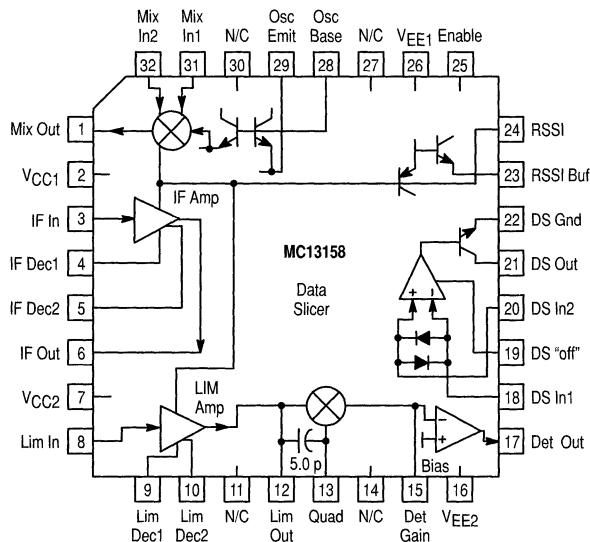
## MC13158FTB

$T_A = -40^\circ$  to  $+85^\circ\text{C}$ , Case 873

The MC13158 is a wideband IF subsystem that is designed for high performance data and analog applications. Excellent high frequency performance is achieved, with low cost, through the use of Motorola's MOSAIC 1.5™ RF bipolar process. The MC13158 has an on-board grounded collector VCO transistor that may be used with a fundamental or overtone crystal in single channel operation or with a PLL in multi-channel operation. The mixer is useful to 500 MHz and may be used in a balanced differential or single ended configuration. The IF amplifier is split to accommodate two low cost cascaded filters. RSSI output is derived by summing the output of both IF sections. A precision data shaper has an Off function to shut the output "off" to save current. An enable control is provided to power down the IC for power management in battery operated applications.

Applications include DECT, wideband wireless data links for personal and portable laptop computers and other battery operated radio systems which utilize GFSK, FSK or FM modulation.

- Designed for DECT Applications
- 1.8 to 6.0 Vdc Operating Voltage
- Low Power Consumption in Active and Standby Mode
- Greater than 600 kHz Detector Bandwidth
- Data Slicer with Special Off Function
- Enable Function for Power Down of Battery Operated Systems
- RSSI Dynamic Range of 80 dB Minimum
- Low External Component Count



# UHF, FM/AM Transmitter

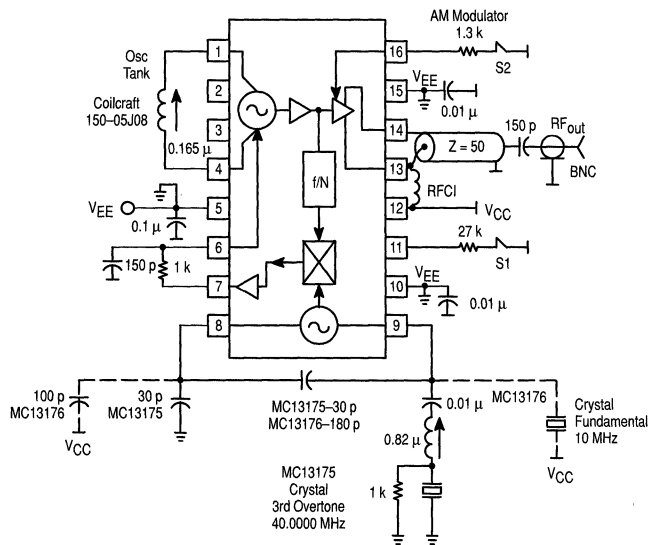
## MC13175/176D

$T_A = 0^\circ$  to  $+70^\circ\text{C}$ , Case 751B

The MC13175 and MC13176 are one chip FM/AM transmitter subsystems designed for AM/FM communication systems operating in the 260 to 470 MHz band covered by FCC Title 47; Part 15. They include a Colpitts crystal reference oscillator, UHF oscillator, +8 (MC13175) or +32 (MC13176) prescaler, and phase detector forming a versatile PLL system. Another application is as a local oscillator in a UHF or 900 MHz receiver. MC13175/176 offer the following features:

- UHF Current Controlled Oscillator
- Use Easily Available 3rd Overtone or Fundamental Crystals for Reference

- Low Number of External Parts Required
- Low Operating Supply Voltage (1.8–5 Vdc)
- Low Supply Drain Currents
- Power Output Adjustable (Up to +10 dBm)
- Differential Output for Loop Antenna or Balun Transformer Networks
- Power Down Feature
- ASK Modulated by Switching Output "On"/"Off"
- MC13175 –  $f_O = 8 \times f_{ref}$
- MC13176 –  $f_O = 32 \times f_{ref}$



# Telecommunications

## Subscriber Loop Interface Circuit (SLIC)

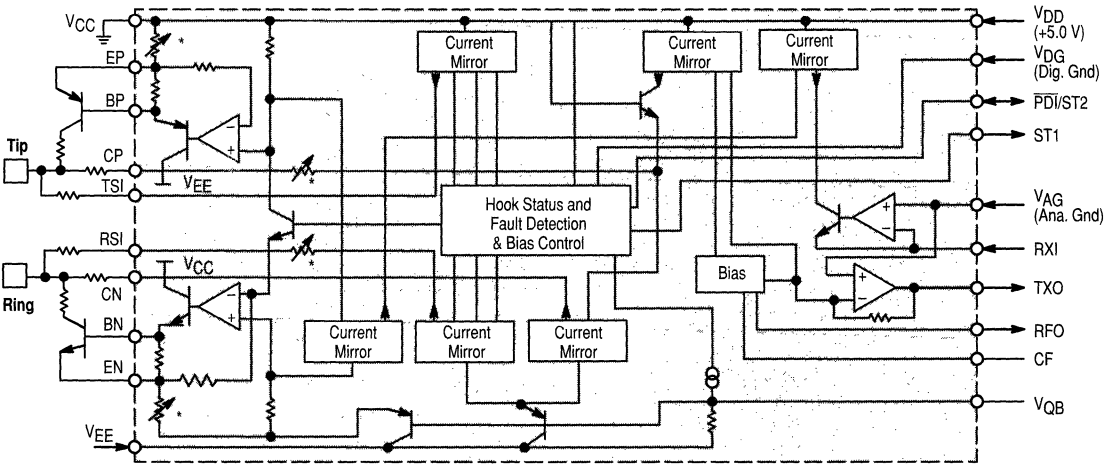
MC33120/1P, FN

T<sub>A</sub> = -40° to +85°C, Case 738, 776

With a guaranteed minimum longitudinal balance of 58 dB, the MC33120/1 is ideally suited for Central Office applications, as well as PBXs, and other related equipment. Protection and sensing components on the two-wire side can be non-precision while achieving required system performance. Most BORSHT functions are provided while maintaining low power consumption, and a cost effective design. Size and weight reduction over conventional transformer designs permit a higher density system.

- All Key Parameters Externally Programmable with Resistors:
  - Transmit and Receive Gains
  - Transhybrid Loss

- Return Loss
- DC Loop Current Limit and Battery Feed Resistance
- Longitudinal Impedance
- Single and Double Fault Sensing and Protection
- Minimum 58 dB Longitudinal Balance (2-wire and 4-wire) Guaranteed
- Digital Hook Status and Fault Outputs
- Power Down Input
- Loop Start or Ground Start Operation
- Size & Weight Reduction Over Conventional Approaches
- Available in 20 Pin DIP and 28 Pin PLCC Packages
- Battery Voltage: -42 to -58 V (for MC33120), -21.6 to -42 V (for MC33121)



(Battery)

\* Indicates Trimmed Resistor

# PBX Architecture (Analog Transmission)

## PCM Monocircuits Codec-Filters (CMOS LSI)

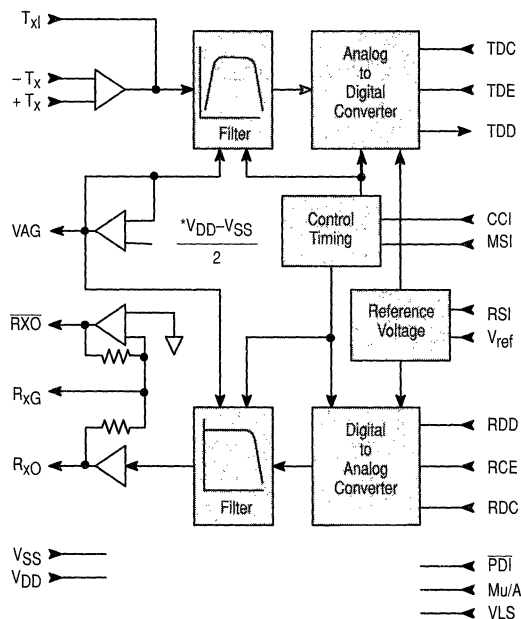
### MC145500 Series

Case 648, 708, 751G, 776

The Monocircuits perform the digitizing and restoration of the analog signals. In addition to these important functions, Motorola's family of pulse-code modulation monocircuits also provides the band-limiting filter functions - all on a single monolithic CMOS chip with extremely low power dissipation.

The Monocircuits require no external components. They incorporate the bandpass filter required for antialiasing and 60 Hz rejection, the A/D-D/A conversion functions for either U.S. Mu-Law or European A-Law companding formats, the low-pass filter required for reconstruction smoothing, an on-board precision voltage reference, and a variety of options that lend flexibility to circuit implementations. Unique features of Motorola's monocircuit family include wide power supply range (6.0 to 13 V), selectable on-board voltage reference (2.5, 3.1, or 3.8 V), and TTL or CMOS I/O interface.

Motorola supplies three versions in this series. The MC145503 and MC145505 are general-purpose devices in 16 pin packages designed to operate in digital telephone or line card applications. The MC145502 is the full-feature device that presents all of the options available on the chip. This device is packaged in a 22 pin DIP and 28 pin chip carrier package.



### MC145554/57/64/67

Case 648, 751D, 751G, 738

These per channel PCM Codec-Filters perform the voice digitization and reconstruction as well as the band limiting and smoothing required for PCM systems. They are designed to operate in both synchronous and asynchronous applications and contain an on-chip precision voltage reference. The MC145554 (Mu-Law) and MC145557 (A-Law) are general purpose devices that are offered in 16 pin packages. The MC145564 (Mu-Law) and MC145567 (A-Law), offered in 20 pin packages, add the capability of analog loop-back and push-pull power amplifiers with adjustable gain.

All four devices include the transmit bandpass and receive lowpass filters on-chip, as well as active RC pre-filtering and post-filtering. Fully differential analog circuit design assures lowest noise. Performance is specified over the extended temperature range of  $-40^{\circ}$  to  $+85^{\circ}$ C.

These PCM Codec-Filters accept both industry standard clock formats. They also maintain compatibility with Motorola's family of MC3419/MC33120 SLIC products.

### MC14LC5480P, DW, SD

Case 738, 751D, 940C-02

This 5.0 V, general purpose per channel PCM Codec-Filter offers selectable Mu-Law or A-Law companding in 20 pin DIP, SOG and SSOP packages. It performs the voice digitization and reconstruction as well as the band limiting and smoothing required for PCM systems. It is designed to operate in both synchronous and asynchronous applications and contains an on-chip precision reference voltage (1.575 V).

The transmit bandpass and receive lowpass filters, and the active RC pre-filtering and post-filtering are incorporated, as well as fully differential analog circuit design for lowest noise. Push-pull 300  $\Omega$  power drivers with external gain adjust are also included.

The MC14LC5480 PCM Codec-Filter accepts a variety of clock formats, including short-frame sync, long-frame sync, IDL, and GCI timing environments. This device also maintains compatibility with Motorola's family of Telecom products, including the MC145472 U-Interface Transceiver, MC145474/75 S/T-Interface Transceiver, MC145572 U-Interface Transceiver, MC145574 S/T-Interface Transceiver, MC145532 ADPCM Transcoder, MC145422/26 UDLT-I, MC145421/25 UDLT-II, and MC33120 SLIC.

Replaces the MC145480P, DW, SD.

## PBX Architecture (continued)

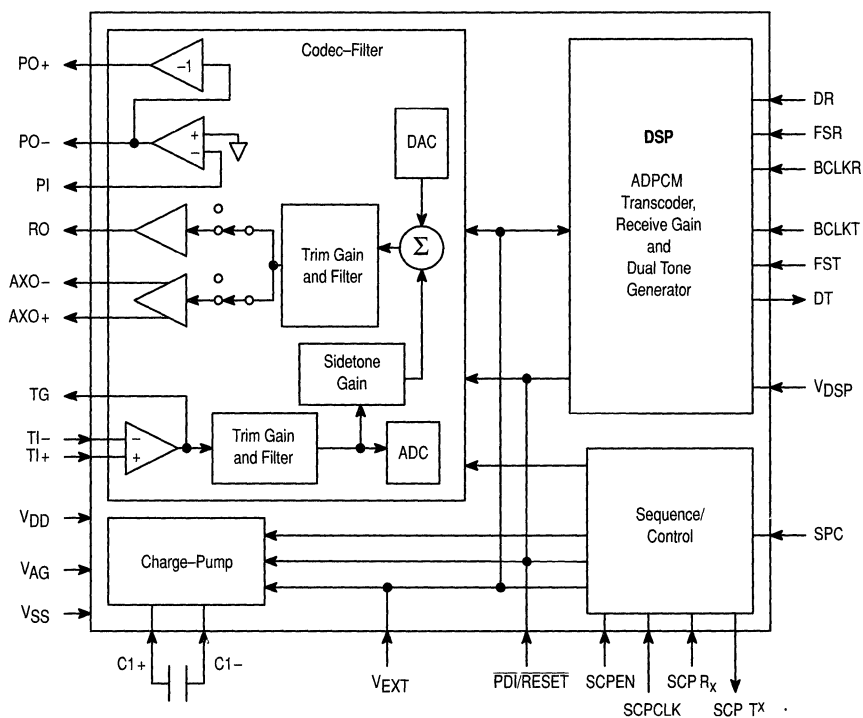
### MC14LC5540P, DW, FU

Case 710, 751F, 873

The MC14LC5540 ADPCM Codec is a single chip implementation of a PCM Codec-Filter and an ADPCM encoder/decoder, and therefore provides an efficient solution for applications requiring the digitization and compression of voiceband signals. This device is designed to operate over a wide voltage range, 2.7 V to 5.25 V, and as such is ideal for battery powered as well as ac powered applications. The MC14LC5540 ADPCM Codec also includes a serial control port and internal control and status registers that permit a microcomputer to exercise many built-in features.

The ADPCM Codec is designed to meet the 32 kbps ADPCM conformance requirements of CCITT Recommendation G.721 (1988) and ANSI T1.301 (1987). It also meets ANSI T1.303 and CCITT Recommendation G.723 for 24 kbps ADPCM operation, and the 16 kbps ADPCM standard, CCITT Recommendation G.726. This device also meets the PCM conformance specification of the CCITT G.714 Recommendation.

Figure 1. MC14LC5540 ADPCM Codec Block Diagram



## PBX Architecture (continued)

### MC145537EVK

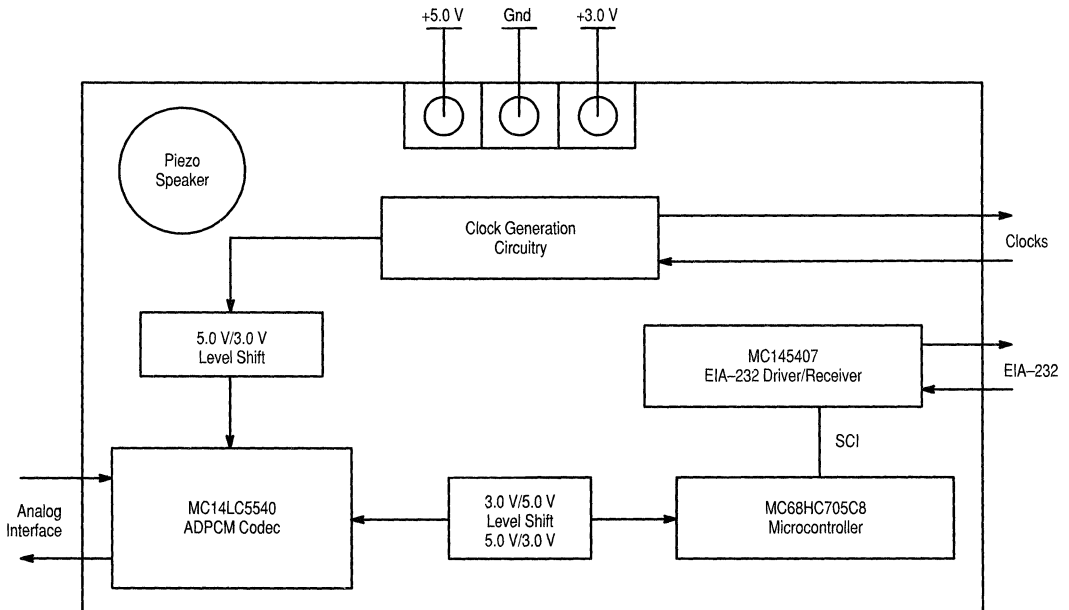
#### ADPCM Codec Evaluation Kit

The MC145537EVK is the primary tool for evaluation and demonstration of the MC14LC5540 ADPCM Codec. It provides the necessary hardware and software interface to access the many features and operational modes of the MC14LC5540 ADPCM Codec.

- Provides Stand Alone Evaluation on Single Board
- The kit provides Analog-to-Analog, Analog-to-Digital or Digital-to-Analog Connections – with Digital Connections being 64 kbps PCM, 32 or 24 kbps ADPCM, or 16 kbps CCITT G.726 or Motorola Proprietary ADPCM
- +5.0 V Only Power Supply, or 5.0 V Plus 2.7 to 5.25 V Supply

- Easily Interfaced to Test Equipment, Customer System, Second MC145537EVK or MC145536EVK (5.0 V Only) for Full Duplex Operation
- Convenient Access to Key Signals
- Piezo Loudspeaker
- EIA-232 Serial Computer Terminal Interface for Control of the MC14LC5540 ADPCM Codec Features
- Compatible Handset Provided
- Schematics, Data Sheets, and User's Manual Included

Figure 2. MC145537EVK Block Diagram





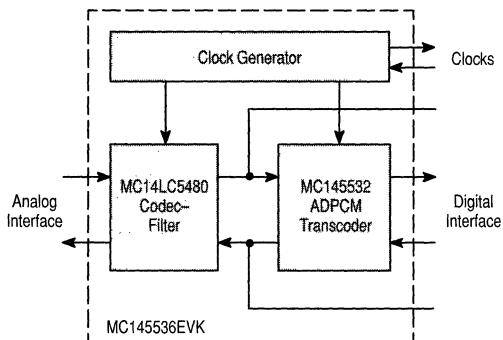
## PBX Architecture (continued)

### MC145536EVK

Codec-Filter/ADPCM Transcoder Evaluation Kit

The MC145536EVK is the primary tool for evaluation and demonstration of the MC14LC5480 Single +5.0 V supply PCM Codec-Filter and the MC145532 ADPCM Transcoder (see "Telephone Accessory Circuits"). The MC145536EVK provides the necessary hardware needed to evaluate the many separate operating modes under which the MC14LC5480 and MC145532 are intended to operate.

- Provides Stand Alone Evaluation on a Single Board
- Easily Interfaced to Test Equipment, Customer System, or Second MC145536EVK
- Convenient Access to Key Signals
- Generous Wire-Wrap Area for Application Development
- The kit provides Analog-to-Analog, Analog-to-Digital, or Digital-to-Analog Connections – with Digital Connections Being 64 kbps PCM; 32, 24, or 16 kbps Motorola Proprietary ADPCM
- Compatible Handset Included
- Schematics, Data Sheets, and User's Manual included



## Dual Tone Multiple Frequency Receiver

### MC145436AP, DW

Case 646, 751G

This device contains the filter and decoder for detection of a pair of tones conforming to the DTMF standard with outputs in hexadecimal. Switched capacitor filter technology is used together with digital circuitry for the timing control and output circuits. The MC145436A provides excellent power-line noise and dial tone rejection.

Replaces MC145436P, DW.

## ISDN Voice/Data Circuits

### Integrated Services Digital Network

ISDN is the revolutionary concept of converting the present analog telephone networks to an end-to-end global digital network. ISDN standards make possible a wide variety of services and capabilities that are revolutionizing communications in virtually every industry.

Motorola's ISDN product family includes the MC14LC5472 and MC145572 U-Interface Transceivers, the MC145474/75 and MC145574 S/T-Interface Transceivers, MC145488 Dual Data Link Controller, and the MC68302 Integrated Multi-Protocol Processor. These are supported by a host of related devices including the MC14LC5480 +5.0 V PCM Codec-Filter, MC145532 ADPCM Transcoder, MC14LC5540 ADPCM Codec, MC145500 family of single-chip codec/filters, MC145436A DTMF Decoder, MC33120 Subscriber Loop Interface Circuit, MC34129 Switching Power Supply Controller, and the MC145406/07 CMOS EIA 232-E Driver/ Receiver family.

Motorola's key ISDN devices fit into four ISDN network applications: a digital subscriber line card, an NT1 network termination, an ISDN terminal adapter, and an ISDN terminal. Digital subscriber line cards are used in central offices, remote concentrators, channel banks, T1 multiplexers, and other switching equipment. The NT1 network termination block illustrates the simplicity of remote U- to S/T-interface conversion. The ISDN terminal adapter and ISDN terminal block show how Motorola ICs are used to combine voice and data in PC compatible boards, digital telephones, and other terminal equipment. Expanded applications such as a PBX may include these and other Motorola ISDN circuits. Many "non-ISDN" uses, such as pairgain applications, are appropriate for Motorola's ISDN devices as well.

## Second Generation U-Interface Transceivers

### MC145572PB

Case 824D

### MC145572FN

Case 777

The MC145572 fully conforms to ANSI T1.601-1992, the North American standard for ISDN Basic Access on a single twisted-wire pair. The transceiver achieves a remarkable  $10^{-7}$  bit error rate performance on all ANSI specified test loops with worst-case impairments present. The state-of-the-art 0.65 micron single-chip solution uses advanced design techniques to combine precision analog signal processing elements with three digital signal coprocessors to build an adaptively equalized echo cancelling receiver.

Two modes of handling U-interface maintenance functions are provided on the MC145572. In the automatic maintenance mode the U-interface transceiver handles all ANSI specified maintenance and channel procedures internally to minimize your software development effort. Automatic procedures include generating and monitoring the cyclic redundancy check, reporting and counting far end block errors (near end block errors too), handling the ACT and DEA bits, as well as monitoring and appropriately responding to embedded operations channel messages.

The MC145572 has 275 mW maximum power dissipation. It also has an enhanced TDM interface that supports an on-chip timeslot assigner, GCI and IDL modes of operation.

The optional manual maintenance mode lets you choose an inexpensive microcontroller, such as a member of Motorola's MC68HC05 family, to control and augment the

standard maintenance channel functions. This flexible feature also allows for easy implementation of proprietary maintenance functions.

## Second Generation S/T-Interface Transceivers

### MC145574PB

Case 873A

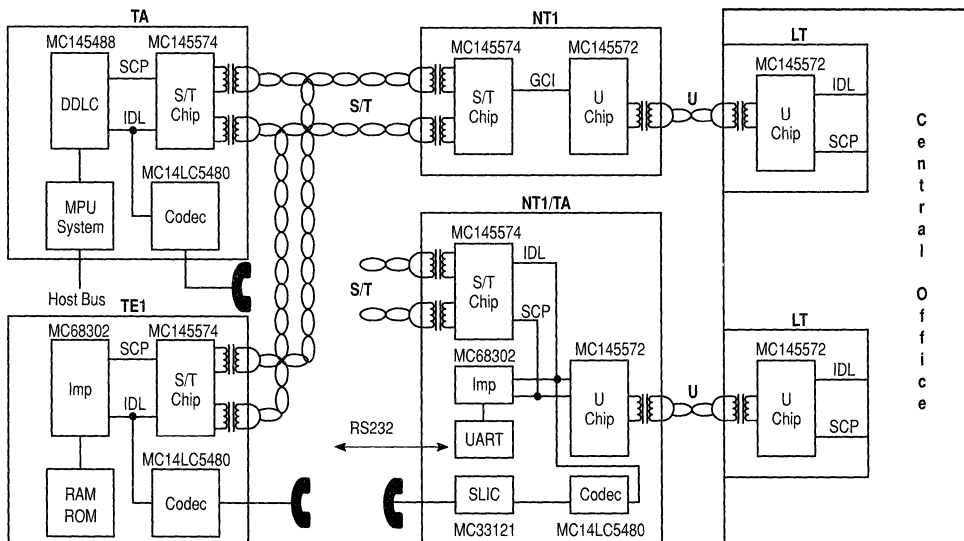
### MC145574DW

Case 751F

The MC145574 S/T-Interface Transceivers provide a CCITT 1.430 compatible interface for use in line card, network termination, and ISDN terminal equipment applications. Manufactured with Motorola's advanced 0.65 micron CMOS mixed analog and digital process technology, the MC145574 is a physical layer device capable of operating in point-to-point or point-to-multipoint passive bus arrangements. In addition, the MC145574 implements the optional NT1 Star topology, NT terminal mode and TE slave mode.

This device features outstanding transmission performance. It reliably transmits over 1 kilometer in a point-to-point application. Comparable performance is achieved in all other topologies as well. Other features include pin selectable terminal or network operating modes, industry standard microprocessor serial control port, full support of the multiframing S and Q channels, a full range of loopbacks, and low power CMOS operation, with a maximum power consumption of 90 mW.

The MC145574 has an enhanced TDM interface that supports GCI, IDL and an on-chip timeslot assigner.



## ISDN Voice/Data Circuits (continued)

### Dual Data Link Controller

#### MC145488FN

Case 779

The MC145488 features two full-duplex serial HDLC channels with an on-chip Direct Memory Access (DMA) controller. The DMA controller minimizes the number of microprocessor interrupts from the communications channels, freeing the microprocessor's resources for other tasks. The DMA controller can access up to 64 kbytes of memory, and transfers either 8-bit bytes or 16-bit words to or from memory. The MC145488 DDLC is compatible with Motorola's MC68000 and other microprocessors.

In a typical ISDN terminal application, one DDLC communications channel supports the D-channel (LAPD) while the other supports the B-channel (LAPB). While the DDLC is ideally suited for ISDN applications, it can support many other HDLC protocol applications as well.

Some of the powerful extras found on the DDLC include automatic abort and retransmit of D-channel collisions in S/T-interface applications, address recognition, automatic recovery mechanisms for faulty frame correction, and several system test modes. Address recognition provides a reduction in the host microprocessor load by filtering data frames not addressed to the host. The DDLC can compare either SAPI or TEI fields of LAPD frames. For LAPD (Q.921) applications, both A and B addresses may be checked.

#### MC14LC5494EVK

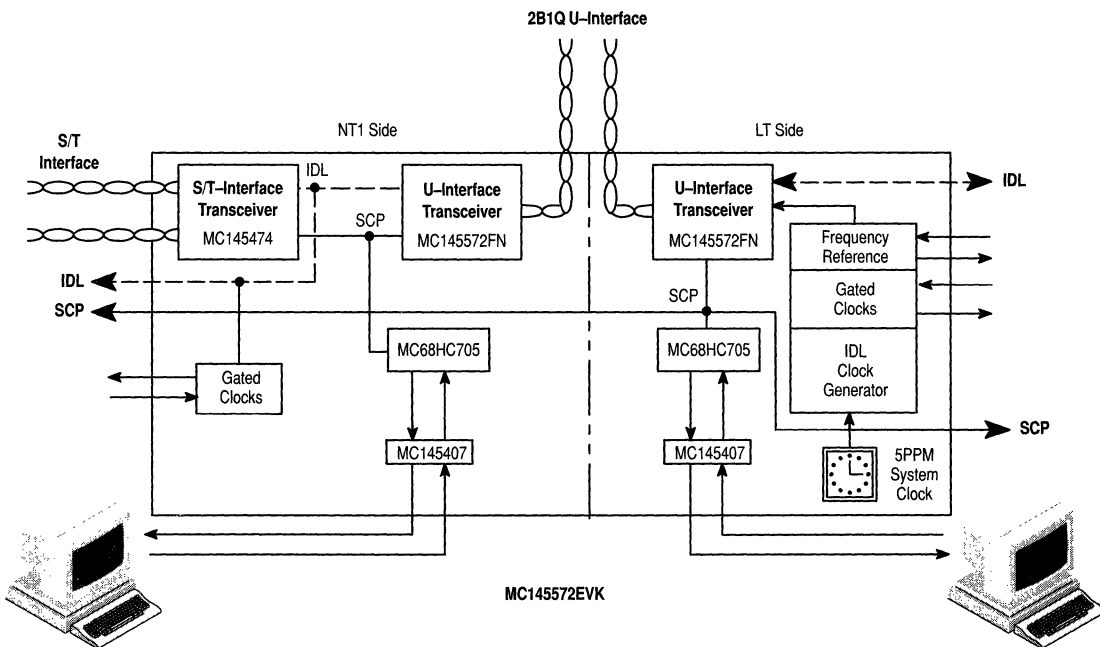
U-Interface Transceiver Evaluation Kit discontinued

#### MC145572EVK

U-Interface Transceiver Evaluation Kit

This kit provides the hardware and software to evaluate the many configurations under which the MC145572EVK is able to operate. Used as a whole, it operates as both ends of the two-wire U interface that extends from the customer premises (NT1) to the switch line card (LT). The two halves of the board can be physically and functionally separated, providing independent NT1 and LT evaluation capability.

The kit provides the ability to interactively manipulate status registers in the MC145572EVK U-Interface transceiver or in the MC145474/75 S/T-Interface transceiver with the aid of an external terminal. The device can also be controlled using the MC68302 Integrated Multiprotocol Processor application development system to complete a total Basic Rate ISDN evaluation solution.



# Voice/Data Communication (Digital Transmission)

## 2-Wire Universal Digital Loop Transceiver (UDLT)

### MC145422P, DW Master Station

Case 708, 751E

### MC145426P, DW Slave Station

Case 708, 751E

The UDLT family of transceivers allows the use of existing twisted-pair telephone lines (between conventional telephones and a PBX) for the transmission of digital data. With the UDLT, every voice-only telephone station in a PBX system can be upgraded to a digital telephone station that handles the complex voice/data communications with no increase in cabling costs.

In implementing a UDLT-based system the A/D to D/A conversion function associated with each telset is relocated from the PBX directly to the telset. The SLIC (or its equivalent circuit) is eliminated since its signaling information is transmitted digitally between two UDLTs.

The UDLT master-slave system incorporates the modulation/demodulation functions that permit data communications over a distance up to 2 kilometers. It also provides the sequence control that governs the exchange of information between master and slave. Specifically, the master resides on the PBX line card where it transmits and receives data over the wire pair to the telset. The slave is located in the telset and interfaces the monocircuit to the wire pair. Data transfer occurs in 10-bit bursts (8 bits of data and 2 signaling bits), with the master transmitting first, and the slave responding in a synchronized half-duplex transmission format.

UDLTs utilize a 256 kilobaud Modified Differential Phase Shift Keyed (MDPSK) burst modulation technique for transmission to minimize radio frequency, electromagnetic, and crosstalk interference. Implementation through CMOS technology takes advantage of low-power operation, increased reliability, and the proven capabilities to perform complex telecommunications functions.

### Functional Features

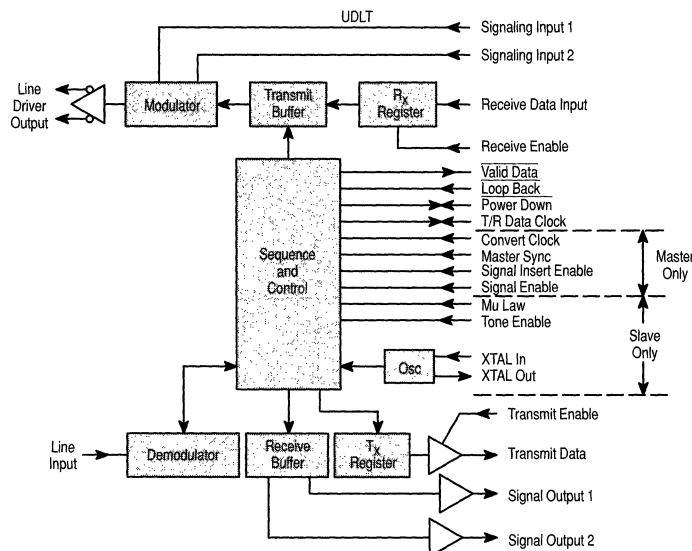
- Provides Synchronous Duplex 64 kbits/Second Voice/Data Channel and Two 8 kbits/Second Signaling Data Channels Over One 26 AWG Wire Pair Up to 2 km.
- Compatible with Existing and Evolving Telephone Switch Architectures and Call Signaling Schemes
- Automatic Detection Threshold Adjustment for Optimum Performance Over Varying Signal Attenuations
- Protocol Independent
- Single 5.0 V to 8.0 V Power Supply

### MC145422 Master UDLT

- 2.048 MHz Master Clock
- Pin Controlled Power-Down and Loop-Back Features
- Variable Data Clock - 64 kHz to 2.56 MHz
- Pin Controlled Insertion/Extraction of 8 kbits/Seconds Channel into LSB of 64 kbits/Second Channel for Simultaneous Routing of Voice and Data Through PCM Voice Path of Telephone Switch

### MC145426 Slave UDLT

- Compatible with MC145500 Series and Later PCM Codec-Filters
- Automatic Power-Up/Down Feature
- On-Chip Data Clock Recovery and Generation
- Pin Controlled 500 Hz D3 or CCITT Format PCM Tone Generator for Audible Feedback Applications



## Voice/Data Communication (Digital Transmission) (continued)

### 2-Wire ISDN Universal Digital Loop Transceiver II (UDLT II)

#### MC145421P, DW Master

Case 709, 751E

#### MC145425P, DW Slave

Case 709, 751E

Similar to the MC145422/26 UDLT, but provide synchronous full duplex 160 kbps voice and data communication in a 2B + 2D format for ISDN compatibility on a single twisted pair up to 1 km. Single 5.0 V power supply, protocol independent.

## Electronic Telephone

### The Complete Electronic Telephone Circuit

#### MC34010P, FN

$T_A = -20^\circ$  to  $+60^\circ\text{C}$ , Case 711, 777

The conventional transformer-driven telephone handset is undergoing major innovations. The bulky transformer is disappearing. So are many of its discrete components, including the familiar telephone bell. They are being replaced with integrated circuits that perform all the major handset functions simply, reliably and inexpensively . . . functions such as 2-to-4 wire conversion, DTMF dialing, tone ringing, and a variety of related activities.

The culmination of these capabilities is the Electronic Telephone Circuit, the MC34010. These ICs place all of the above mentioned functions on a single monolithic chip.

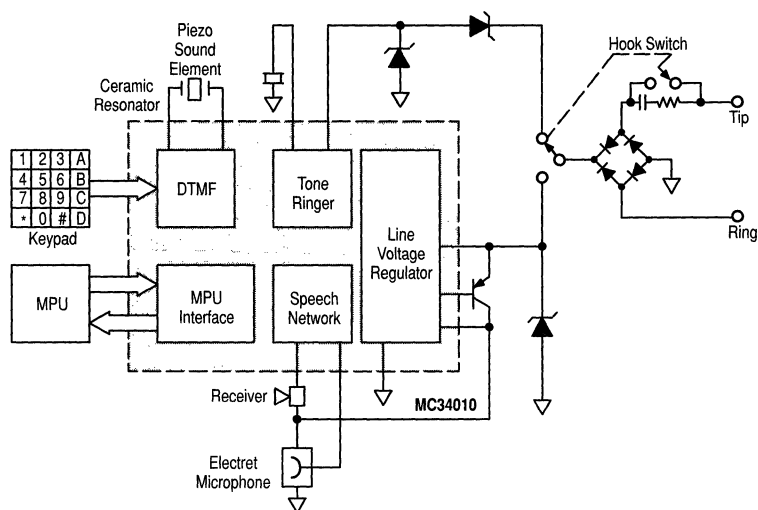
These telephone circuits utilize advanced bipolar analog ( $i^2L$ ) technology and provide all the necessary elements of a modern tone-dialing telephone. The MC34010 even incorporates an MPU interface circuit for the inclusion of automatic dialing in the final system.

- Provides all basic telephone functions, including DTMF dialer, tone ringer, speech network and line voltage regulator

- DTMF generator uses low cost ceramic resonator with accurate frequency synthesis technique
- Tone ringer drives piezoelectric transducer and satisfies EIA-470 requirements
- Speech network provides 2-to-4 wire conversion with adjustable sidetone utilizing an electret transmitter
- On-chip regulator insures stable operation over wide range of loop lengths
- $i^2L$  technology provides low 1.4 V operation and high static discharge immunity
- Microprocessor interface port for automatic dialing features

#### Also Available

A broad line of additional telephone components for customizing systems design.



# Tone Ringers

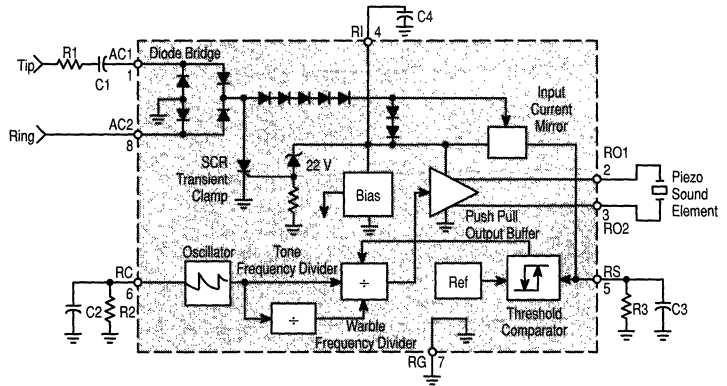
The MC34017 Tone Ringer is designed to replace the bulky bell assembly of a telephone, while providing the same function and performance under a variety of conditions. The operational requirements spelled out by the FCC and EIA-470, simply stated, are that a ringer circuit MUST function

when a ringing signal is provided, and MUST NOT ring when other signals (speech, dialing, noise) are on the line. The tone ringers described below were designed to meet those requirements with a minimum of external components.

## MC34017P, D

$T_A = -20^\circ$  to  $+60^\circ\text{C}$ , Case 626, 751

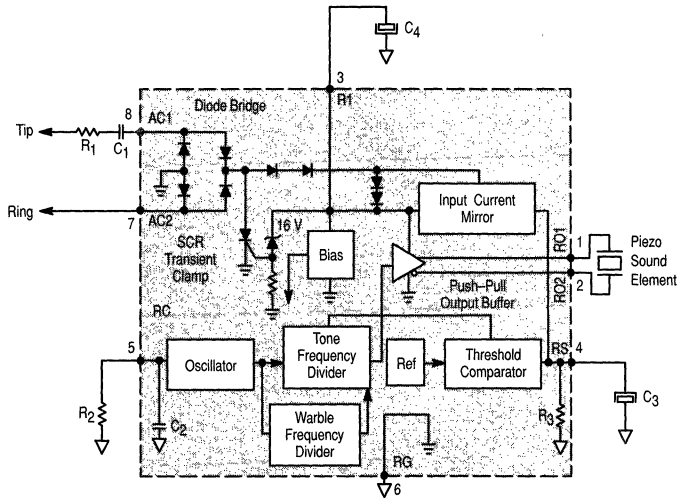
- Complete Telephone Bell Replacement Circuit with Minimum External Components
- On-Chip Diode Bridge and Transient Protection
- Direct Drive for Piezoelectric Transducers
- Push Pull Output Stage for Greater Output Power Capability
- Base Frequency Options
  - MC34017-1: 1.0 kHz
  - MC34017-2: 2.0 kHz
  - MC34017-3: 500 Hz
- Input Impedance Signature Meets Bell and EIA Standards
- Rejects Rotary Dial Transients



## MC34217P, D

$T_A = -20^\circ$  to  $+60^\circ\text{C}$ , Case 626, 751

- Complete Telephone Bell Replacement
- On-Chip Diode Bridge
- Internal Transient Protection
- Differential Output to Piezo Transducer for Louder Sound
- Input Impedance Signature Meets Bell and EIA Standards
- Rejects Rotary Dial and Hook Switch Transients
- Base Frequency and Warble Frequencies are Independently Adjustable
- Adjustable Base Frequency
- Reduced Number of Externals



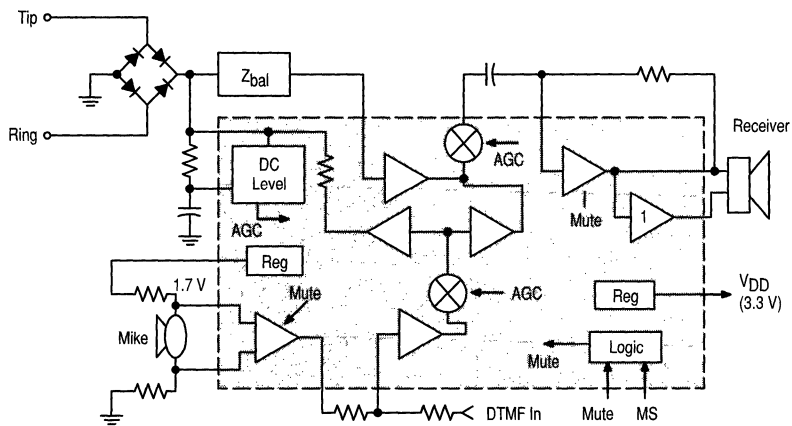
# Speech Networks

## Telephone Speech Network with Dialer Interface

MC34114P, DW

$T_A = -20^\circ$  to  $+70^\circ\text{C}$ , Case 707, 751D

- Operation Down to 1.2 V
- Adjustable Transmit, Receive, and Sidetone Gains by External Resistors
- Differential Microphone Amplifier Input Minimizes RFI
- Transmit, Receive, and Sidetone Equalization on both Voice and DTMF Signals
- Regulated 1.7 V Output for Biasing Microphone
- Regulated 3.3 V Output for Powering External Dialer
- Microphone and Receive Amplifiers Muted During Dialing
- Differential Receive Amplifier Output Eliminates Coupling Capacitor
- Operates with Receiver Impedances of  $150\ \Omega$  and Higher



## Cordless Universal Telephone Interface

### MC34016DW, P

$T_A = -20^\circ$  to  $+70^\circ\text{C}$ , Case 751D, 738

The MC34016 is a telephone line interface meant for use in cordless telephone base stations for CT0, CT1, CT2 and DECT. The circuit forms the interface towards the telephone line and performs all speech and line interface functions like dc and ac line termination, 2–4 wire conversion, automatic gain control and hookswitch control. Adjustment of transmission parameters is accomplished by two 8 bit registers accessible via the integrated serial bus interface and by external components.

- DC Masks for Voltage and Current Regulation
- Supports Passive or Active AC Set Impedance Applications
- Double Wheatstone Bridge Sidetone Architecture
- Symmetrical Inputs and Outputs with Large Signal Swing Capability
- Gain Setting and Mute Function for  $T_X$  and  $R_X$  Amplifiers
- Very Low Noise Performance
- Serial Bus Interface SPI Compatible
- Operation from 3.0 to 5.5 V

### FEATURES

#### Line Driver Architecture

- Two DC Masks for Voltage Regulation
- Two DC Masks for Current Regulation
- Passive or Active Set Impedance Adjustment

- Double Wheatstone Bridge Architecture
- Automatic Gain Control Function

#### Transmit Channel

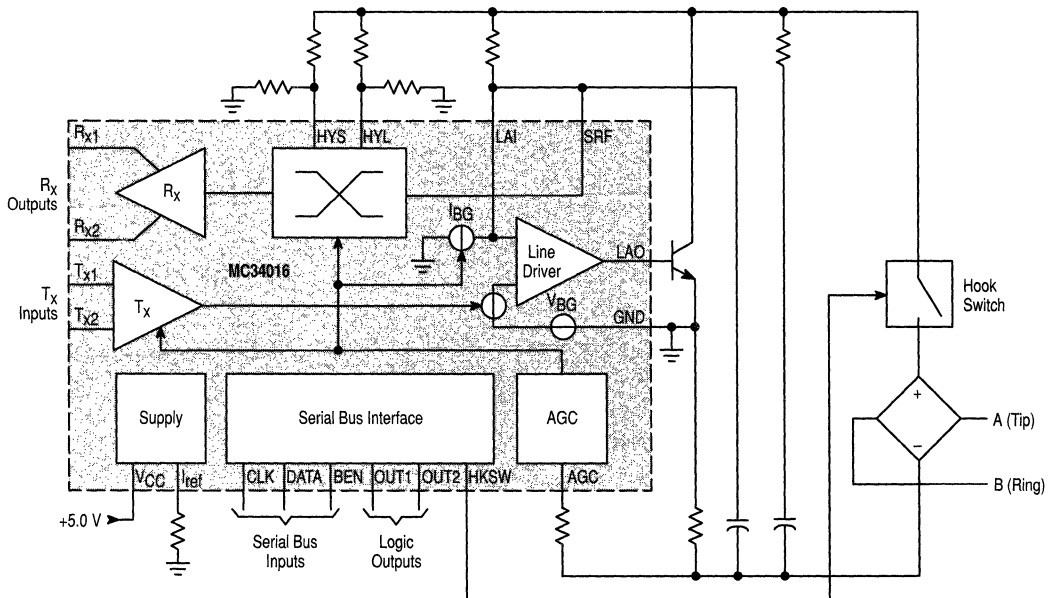
- Symmetrical Inputs Capable of Handling Large Voltage Swing
- Gain Select Option via Serial Bus Interface
- Transmit Mute Function, Programmable via Bus
- Large Voltage Swing Capability at the Telephone Line

#### Receive Channel

- Double Sidetone Architecture for Optimum Line Matching
- Symmetrical Outputs Capable of Producing High Voltage Swing
- Gain Select Option via Serial Bus Interface
- Receive Mute Function, Programmable via Serial Bus

#### Serial Bus Interface

- 3–Wire Connection to Microcontroller
- One Programmable Output Meant for Driving a Hookswitch
- Two Programmable Outputs Capable of Driving Low Ohmic Loads
- Two 8–Bit Registers for Parameter Adjustment





## Programmable Telephone Line Interface Circuit with Loudspeaker Amplifier

### MC34216DW

$T_A = 0^\circ$  to  $+70^\circ\text{C}$ , Case 751F

The MC34216 is developed for use in telephone applications where besides the standard telephone functions also the group listening-in feature is required. In cooperation with a microcontroller, the circuit performs all basic telephone functions including DTMF generation and pulse-dialing. The listening-in part includes a loudspeaker amplifier, an anti-howling circuit and a strong supply. In combination with the TCA3385, the ringing is performed via the loudspeaker.

### FEATURES

#### Line Driver and Supply

- DC and AC Termination of the Line
- Selectable Masks: France, U.K., Low Voltage
- Current Protection
- Adjustable Set Impedance for Resistive and Complex Termination
- Efficient Supply Point for Loudspeaker Amplifier and Peripherals

#### Handset Operation

- Transmit and Receive Amplifiers
- Adjustable Sidetone Network
- Line Length AGC
- Microphone and Earpiece Mute

- Earpiece Gain Increase Switch
- Microphone Squelch Function
- Transmit Amplifier Soft Clipping

#### Dialing and Ringing

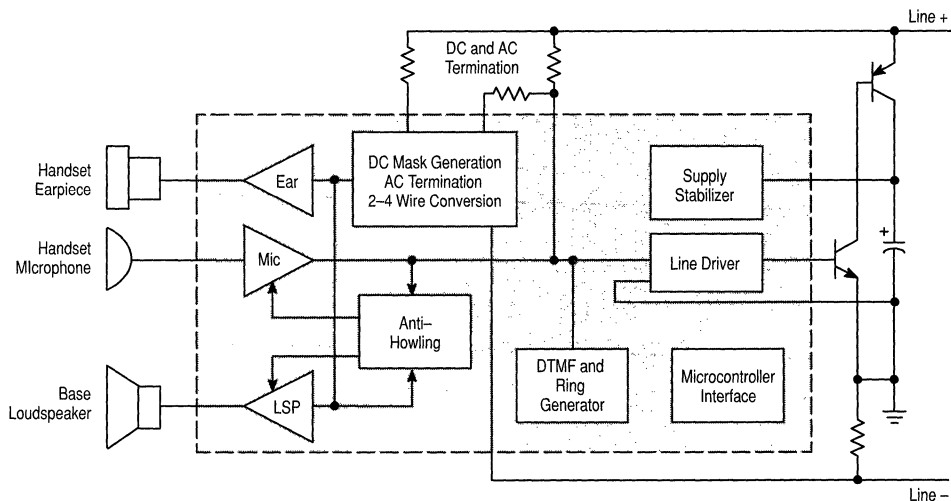
- Generates DTMF, Pilot Tones and Ring Signal
- Interrupter Driver for Pulse-Dialing
- Low Current While Pulse-Dialing
- Optimized for Ringing via Loudspeaker
- Programmable Ring Melodies
- Uses Inexpensive 500 kHz Resonator

#### Loudspeaking Facility

- Integrated Loudspeaker Amplifier
- Peak-to-Peak Limiter Prevents Distortion
- Programmable Volume
- Anti-Howling Circuitry for Group Listening-In
- Interfacing for Handsfree Conversation

#### Application Areas

- Corded Telephony with Group Listening-In
- Cordless Telephony Base Station with Group Listening-In
- Telephones with Answering Machines
- Fax, Intercom, Modem



## Telephone Line Interface

### TCA3388DP, FP

$T_A = 0^\circ$  to  $+70^\circ\text{C}$ , Case 738, 751D

The TCA3388 is a telephone line interface circuit which performs the basic functions of a telephone set in combination with a microcontroller and a ringer. It includes dc and ac line termination, the hybrid function with 2 adjustable sidetone networks, handset connections and an efficient supply point.

### FEATURES

#### Line Driver and Supply

- DC and AC Termination of the Telephone Line
- Selectable DC Mask: France, U.K., Low Voltage
- Current Protection
- Adjustable Set Impedance for Resistive and Complex Termination
- Efficient Supply Point for Peripherals
- Hook Status Detection

#### Handset Operation

- Transmit and Receive Amplifiers
- Double Anti-Sidetone Network

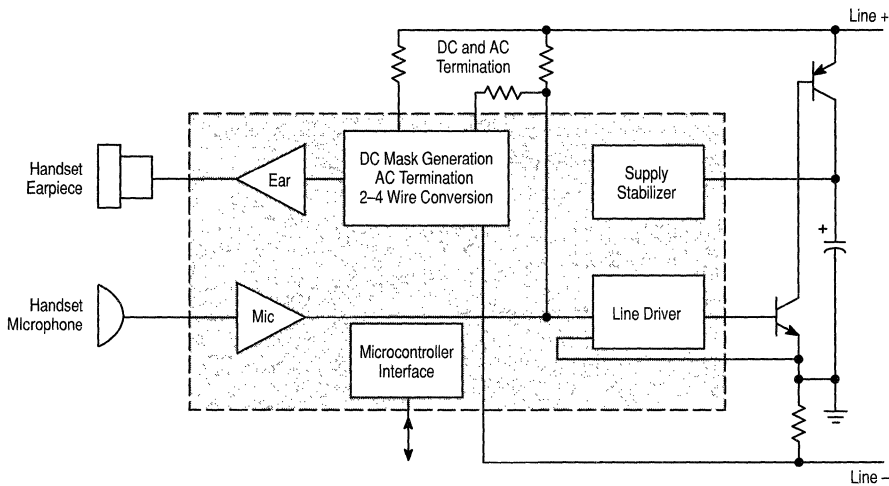
- Line Length AGC
- Microphone and Earpiece Mute
- Transmit Amplifier Soft Clipping

#### Dialing and Ringing

- Interrupter Driver for Pulse-Dialing
- Reduced Current Consumption During Pulse-Dialing
- DTMF Interfacing
- Ringing via External Ringer

#### Application Areas

- Corded Telephony
- Cordless Telephony Base Station
- Answering Machines
- Fax
- Intercom
- Modem



# Speakerphones

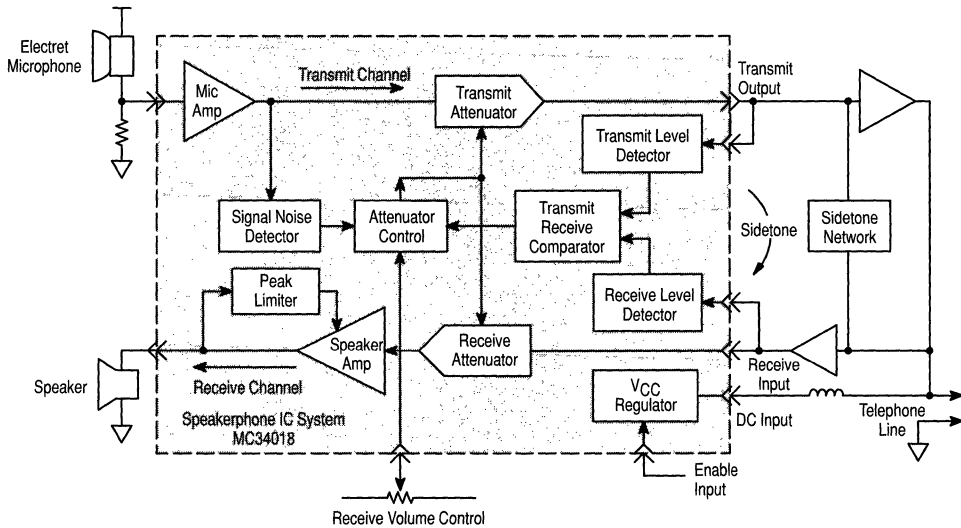
## Voice Switched Speakerphone Circuit

### MC34018P, DW

$T_A = -20^\circ$  to  $+60^\circ\text{C}$ , Case 710, 751F

The MC34018 Speakerphone integrated circuit incorporates the necessary amplifiers, attenuators, and control functions to produce a high quality hands-free speakerphone system. Included are a microphone amplifier, a power audio amplifier for the speaker, transmit and receive attenuators, a monitoring system for background sound level, and an attenuation control system which responds to the relative transmit and receive levels as well as the background level. Also included are all necessary regulated voltages for both internal and external circuitry, allowing line-powered operation (no additional power supplies required). A Chip Select pin allows the chip to be powered down when not in use. A volume control function may be implemented with an external potentiometer. MC34018 applications include speakerphones for household and business uses, intercom systems, automotive telephones, and others.

- All Necessary Level Detection and Attenuation Controls for a Hands-Free Telephone in a Single Integrated Circuit
- Background Noise Level Monitoring with Long Time Constant
- Wide Operating Dynamic Range Through Signal Compression
- On-Chip Supply and Reference Voltage Regulation
- Typical 100 mW Output Power (into 25  $\Omega$ ) with Peak Limiting to Minimize Distortion
- Chip Select Pin for Active/Standby Operation
- Linear Volume Control Function



## Voice Switched Speakerphone Circuit

### MC34118P, DW

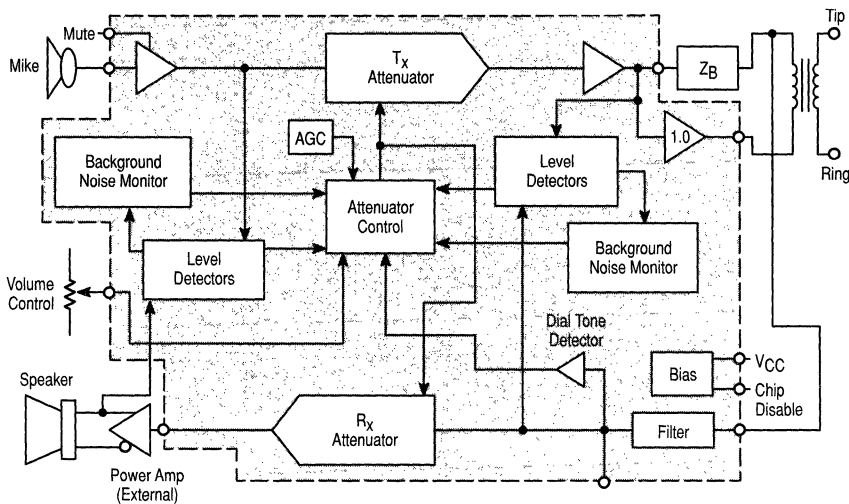
$T_A = -20^\circ$  to  $+60^\circ\text{C}$ , Case 710, 751F

The MC34118 Voice Switched Speakerphone circuit incorporates the necessary amplifiers, attenuators, level detectors, and control algorithm to form the heart of a high quality hands-free speakerphone system. Included are a microphone amplifier with adjustable gain and mute control, Transmit and Receive attenuators which operate in a complementary manner, level detectors at input and output of both attenuators, and background noise monitors for both the transmit and receive channels. A dial tone detector prevents the dial tone from being attenuated by the Receive background noise monitor circuit. Also included are two line driver amplifiers which can be used to form a hybrid network in conjunction with an external coupling transformer. A high-pass filter can be used to filter out 60 Hz noise in the receive channel, or for other filtering functions. A Chip Disable pin permits powering down the entire circuit to conserve power on long loops where loop current is at a minimum.

The MC34118 may be operated from a power supply, or it can be powered from the telephone line, requiring typically

5.0 mA. The MC34118 can be interfaced directly to Tip and Ring (through a coupling transformer) for stand-alone operation, or it can be used in conjunction with a handset speech network and/or other features of a featurephone.

- Improved Attenuator Gain Range: 52 dB Between Transmit and Receive
- Low Voltage Operation for Line-Powered Applications (3.0 to 6.5 V)
- 4-Point Signal Sensing for Improved Sensitivity
- Background Noise Monitors for Both Transmit and Receive Paths
- Microphone Amplifier Gain Set by External Resistors – Mute Function Included
- Chip Disable for Active/Standby Operation
- On Board Filter Pinned-Out for User Defined Function
- Dial Tone Detector Inhibits Receive Idle Mode During Dial Tone Presence
- Compatible with MC34119 Speaker Amplifier



## Speakerphones (continued)

### Voice Switched Speakerphone with $\mu$ Processor Interface

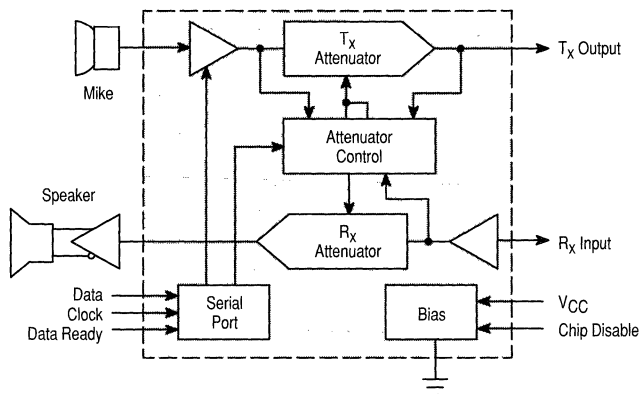
#### MC33218AP, DW

$T_A = -40^\circ$  to  $+85^\circ\text{C}$ , Case 724, 751E

The MC33218A, Voice Switched Speakerphone circuit incorporates the necessary amplifiers, attenuators, level detectors, and control algorithm to form the heart of a high quality hands-free speakerphone system. Included are a microphone amplifier with adjustable gain, and mute control, transmit and receive attenuators which operate in a complementary manner, and level detectors and background noise monitors for both paths. A dial tone detector prevents dial tone from being attenuated by the receive background noise monitor. A Chip Disable pin permits powering down the entire circuit to conserve power.

Also included is an 8-bit serial  $\mu$ processor port for controlling the receive volume, microphone mute, attenuator gain, and operation mode (force to transmit, force to receive, etc.). Data rate can be up to 1.0 MHz. The MC33218A can be operated from a power supply, or from the telephone line, requiring typically 3.8 mA. It can also be used in intercoms and other voice-activated applications.

- Low Voltage Operation: 2.5 to 6.0 V
- 2-Point Sensing, Background Noise Monitor in Each Path
- Chip Disable Pin for Active/Standby Operation
- Microphone Amplifier Gain Set by External Resistors – Mute Function Included
- Dial Tone Detector to Inhibit Receive Idle Mode During Dial Tone Presence
- Microprocessor port for controlling:
  - Receive Volume Level (16 Steps)
  - Attenuator Range (26 or 52 dB, Selectable)
  - Microphone Mute
  - Force to Transmit, Receive, Idle or Normal Voice Switched Operation
- Compatible with MC34119 Speaker Amplifier



## Voice Switched Speakerphone Circuit

### MC33219AP, ADW

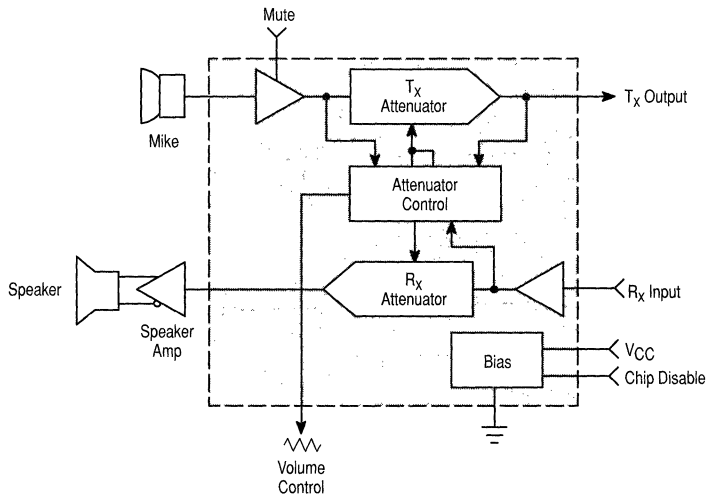
$T_A = -40^\circ$  to  $+85^\circ\text{C}$ , Case 724, 751E

The MC33219A Voice Switched Speakerphone Circuit incorporates the necessary amplifiers, attenuators, level detectors, and control algorithm to form the heart of a high quality hands-free speakerphone system. Included are a microphone amplifier with adjustable gain, and mute control, transmit and receive attenuators which operate in a complementary manner, and level detectors and background noise monitors. A dial tone detector prevents dial tone from being attenuated by the receive background noise monitor. A Chip Disable pin permits powering down the entire circuit to conserve power.

The MC33219A may be operated from a power supply, or it can be powered from the telephone line requiring typically

4.0 mA. The MC33219A can be interfaced directly to Tip and Ring (through a coupling transformer for stand-alone operation, or it can be used in conjunction with a handset speech network and/or other features of a featurephone.

- Low Voltage Operation: 2.7 to 6.0 V
- 2-Point Sensing, Background Noise Monitor in Each Path
- Chip Disable Pin for Active/Standby Operation
- Microphone Amplifier Gain Set by External Resistors – Mute Function Included
- Dial Tone Detector to Inhibit Receive Idle Mode During Dial Tone Presence
- Volume Control Range: 34 dB
- Compatible with MC34119 Speaker Amplifier



## Speakerphones (continued)

# Telephone Line Interface and Speakerphone Circuit

### MC33215B, FB

$T_A = 0^\circ$  to  $+70^\circ\text{C}$ , Case 858, 848B

The MC33215 is a combination speech network/speakerphone developed for use in fully electronic telephone sets with a speakerphone function. The circuit performs the ac and dc line terminations, 2–4 wire conversion, line length AGC and DTMF transmission. The speakerphone part includes a half duplex controller with signal and noise monitoring, base microphone and loudspeaker amplifiers, and an efficient supply. The circuit is designed to operate at low line currents down to 4.0 mA enabling parallel operation with a classical telephone set.

### FEATURES

#### Line Driver and Supply

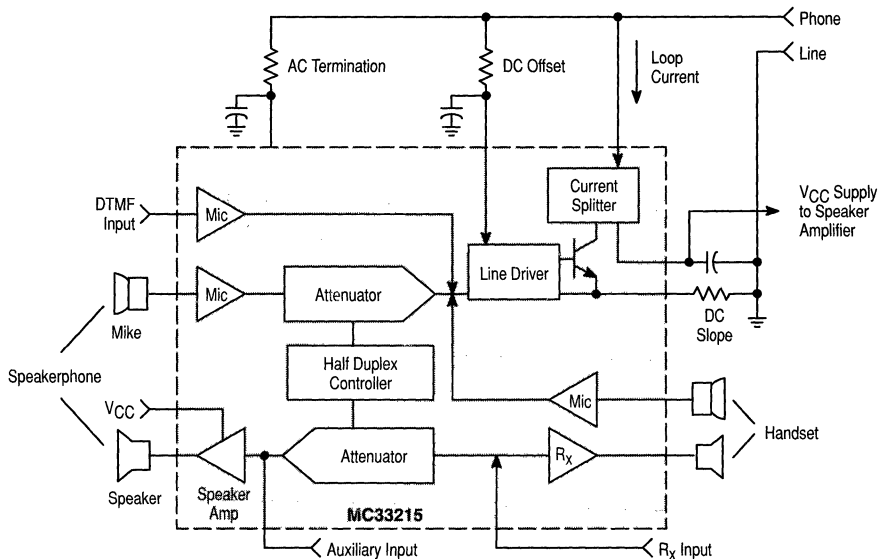
- AC and DC Termination of Telephone Line
- Adjustable Set Impedance for Real and Complex Termination
- Efficient Supply for Speaker Amplifier and Peripherals
- Two Supplies for Handset and Base Microphones
- Separate Supply Arrangement for Handset and Speakerphone Operation

#### Handset Operation

- Transmit and Receive Amplifiers
- Differential Microphone Inputs
- Sidetone Cancellation Network
- Line Length AGC
- Microphone and Earpiece Mute
- Separate Input for DTMF and Auxiliary Signals
- Parallel Operation Down to 4.0 mA of Line Current

#### Speakerphone Operation

- Integrated Microphone and Loudspeaker Amplifiers
- Differential Microphone Inputs
- Loudspeaker Amplifier can be Powered and Used Separately from the Rest of the Circuit
- Integrated Switches for Smooth Switch Over from Handset to Speakerphone Mode
- Signal and Background Noise Monitoring in Both Channels
- Adjustable Switching Depth for Handsfree Operation
- Adjustable Switch Over and Idle Mode Timing
- Dial Tone Detector in the Receive Channel
- Handsfree Operation via Loudspeaker and Base Microphone



## Speakerphones (continued)

**Table 10. The Motorola Family of Speakerphone Integrated Circuits**

MC34018	MC34118	MC33218A	MC33219A
Two point sensing with slow idle, background noise monitor in T <sub>X</sub> path only	Four point sensing with both fast and slow idle modes, background noise monitors in both R <sub>X</sub> and T <sub>X</sub> paths	Two point sensing with slow idle, background noise monitors in both R <sub>X</sub> and T <sub>X</sub> paths	Two point sensing with slow idle, background noise monitors in both R <sub>X</sub> and T <sub>X</sub> paths
No dial tone detector in receive path	Receive path has dial tone detector	Receive path has dial tone detector	Receive path has dial tone detector
Attenuator Characteristics: <ul style="list-style-type: none"> <li>• Range: 44 dB</li> <li>• Tolerance: ±4.0 dB</li> <li>• Gain tracking not specified</li> <li>• White noise is constant</li> </ul>	Attenuator Characteristics: <ul style="list-style-type: none"> <li>• Range: 52 dB</li> <li>• Tolerance: ±2.0 dB</li> <li>• Gain Tracking: &lt;1.0 dB</li> <li>• White noise reduces with volume</li> </ul>	Attenuator Characteristics: <ul style="list-style-type: none"> <li>• Range: 52 or 26 dB (selectable)</li> <li>• Tolerance: ±3.0 dB</li> <li>• Gain Tracking: &lt;1.0 dB</li> <li>• White noise reduces with volume</li> </ul>	Attenuator Characteristics: <ul style="list-style-type: none"> <li>• Range: 52 dB</li> <li>• Tolerance: ±3.0 dB</li> <li>• Gain Tracking: &lt;1.0 dB</li> <li>• White noise reduces with volume</li> </ul>
External hybrid required	Hybrid amplifiers on board	External hybrid required	External hybrid required
Speaker amplifier is on board (34 dB, 100 mW)	External speaker amplifier required (MC34119)	External speaker amplifier required (MC34119)	External speaker amplifier required (MC34119)
Filtering is external	Configurable filter on board	Filtering is external	Filtering is external
Microphone amplifier has fixed gain and no muting	Microphone amplifier has adjustable gain and mute input	Microphone amplifier has adjustable gain, and can be muted through $\mu$ P port	Microphone amplifier has adjustable gain and a mute input
Supply Voltage: 4.0 V to 11 V	Supply Voltage: 2.8 V to 6.5 V	Supply Voltage: 2.5 V to 6.5 V	Supply Voltage: 2.7 V to 6.5 V
Supply Current: 6.5 mA typ., 9.0 mA max	Supply Current: 5.5 mA typ., 8.0 mA max	Supply Current: 4.0 mA typ., 5.0 mA max	Supply Current: 3.0 mA typ., 5.0 mA max
Speaker amplifier reduces gain to prevent clipping	Receive gain is reduced as supply voltage falls to prevent clipping	Receive gain is reduced as supply voltage falls to prevent clipping	Receive gain is reduced as supply voltage falls to prevent clipping
Volume control is linear. Cannot override voice switched operation except through additional circuitry. Attenuator gain is fixed at 44 dB (slightly variable). No microphone mute.	Volume control is linear, and microphone mute has separate pin. Cannot override voice switched operation except through additional circuitry. Attenuator gain is fixed at 52 dB.	8-bit $\mu$ P serial port controls: <ul style="list-style-type: none"> <li>• Volume control (16 steps)</li> <li>• Microphone mute</li> <li>• Range selection (26 dB or 52 dB)</li> <li>• Force to transmit, idle, receive, or normal voice switched operation</li> </ul>	Volume control is linear, and microphone mute has separate pin. Attenuator range fixed at 52 dB. Cannot override voice switched operation except through additional circuitry.
28 Pin DIP and SOIC packages	28 Pin DIP and SOIC packages	24 Pin narrow DIP and SOIC packages	24 Pin narrow DIP and SOIC packages
External Required: <ul style="list-style-type: none"> <li>• 12 Resistors</li> <li>• 11 Capacitors (<math>\leq 1.0 \mu</math>F)</li> <li>• 8 Capacitors (<math>&gt; 1.0 \mu</math>F)</li> </ul>	External Required: <ul style="list-style-type: none"> <li>• 14 Resistors</li> <li>• 12 Capacitors (<math>\leq 1.0 \mu</math>F)</li> <li>• 9 Capacitors (<math>&gt; 1.0 \mu</math>F)</li> </ul>	External Required: <ul style="list-style-type: none"> <li>• 12 Resistors</li> <li>• 11 Capacitors (<math>\leq 1.0 \mu</math>F)</li> <li>• 4 Capacitors (<math>&gt; 1.0 \mu</math>F)</li> </ul>	External Required: <ul style="list-style-type: none"> <li>• 12 Resistors</li> <li>• 11 Capacitors (<math>\leq 1.0 \mu</math>F)</li> <li>• 4 Capacitors (<math>&gt; 1.0 \mu</math>F)</li> </ul>
Temperature Range: -20° to +60°C	Temperature Range: -20° to +60°C	Temperature Range: -40° to +85°C	Temperature Range: -40° to +85°C



# Telephone Accessory Circuits

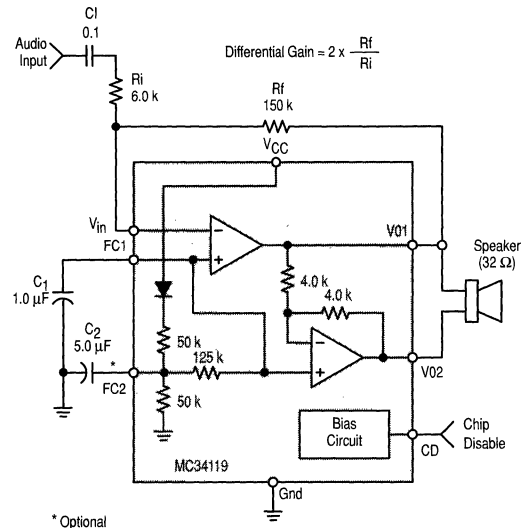
## Audio Amplifier

### MC34119P, D

$T_A = 0^\circ$  to  $+70^\circ\text{C}$ , Case 626, 751

A low power audio amplifier circuit intended (primarily) for telephone applications, such as speakerphones. Provides differential speaker outputs to maximize output swing at low supply voltages (2.0 V min.). Coupling capacitors to the speaker, and snubbers, are not required. Overall gain is externally adjustable from 0 to 46 dB. A Chip Disable pin permits powering-down to mute the audio signal and reduce power consumption.

- Drives a Wide Range of Speaker Loads (16 to 100  $\Omega$ )
- Output Power Exceeds 250 mW with 32  $\Omega$  Speaker
- Low Distortion (THD = 0.4% Typical)
- Wide Operating Supply Voltage (2.0 V to 16 V) – Allows Telephone Line Powered Applications.
- Low Quiescent Supply Current (2.5 mA Typical)
- Low Power-Down Quiescent Current (60  $\mu\text{A}$  Typical)



## Current Mode Switching Regulator

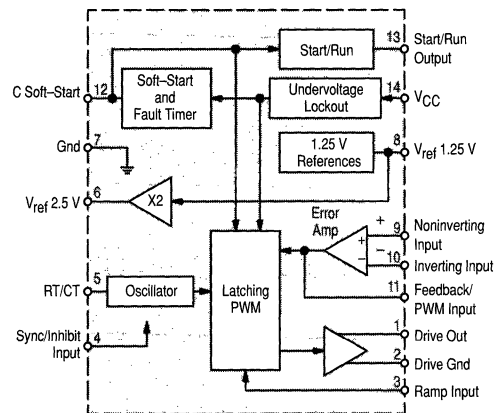
### MC34129P, D

$T_A = 0^\circ$  to  $+70^\circ\text{C}$ , Case 646, 751A

High performance current mode switching regulator for low-power digital telephones. Unique internal fault timer provides automatic restart for overload recovery. A start/run comparator is included to implement bootstrapped operation of  $V_{CC}$ .

Although primarily intended for digital telephone systems, these devices can be used cost effectively in many other applications. On-chip functions and features include:

- Current Mode Operation to 300 kHz
- Automatic Feed Forward Compensation
- Latching PWM for Cycle-By-Cycle Current Limiting
- Latched-Off or Continuous Retry after Fault Timeout
- Soft-Start with Maximum Peak Switch Current Clamp
- Internally Trimmed 2% Bandgap Reference
- Input Undervoltage Lockout



## Telephone Accessory Circuits (continued)

### 300 Baud FSK Modems

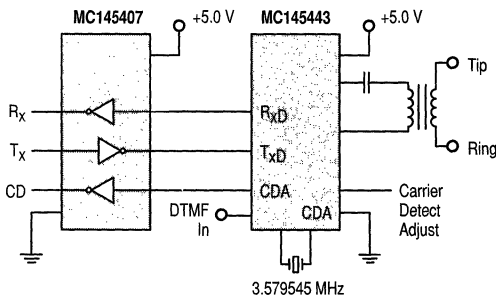
**MC145442P, DW Modem – CCITT V.21**  
Case 738, 751D

**MC145443P, DW Modem – Bell 103**  
Case 738, 751D

This powerful modem combines a complete FSK modulator/demodulator and an accompanying transmit/receive filter system on a single silicon chip. Designed for bidirectional transmission over the telephone network, the modem operates at 300 baud and can be obtained for compatibility with CCITT V.21 and Bell 103 specifications.

The modem contains an on-board carrier-detect circuit that allows direct operation on a telephone line (through a simple transformer), providing simplex, half-duplex, and full-duplex data communications. A built-in power amplifier is capable of driving  $-9.0$  dBm onto a  $600\ \Omega$  line in the transmit mode.

CMOS processing keeps power dissipation to a very low  $45\text{ mW}$ , with a power-down dissipation of only  $1.0\text{ mW}$  . . . from a single  $5.0\text{ V}$  power supply. Available in a 20 pin dual-in-line P suffix, and a wide body surface mount DW suffix.



**MC145444H, DW – CCITT V.21**  
Case 804, 751D

This device is a silicon gate CMOS single-chip 300 baud modem. It is compatible with CCITT V.21 and contains the entire circuit that provides a full-duplex or half-duplex 300 baud data communication over a twisted pair. The MC145444 is capable of driving  $0$  dBm into a  $600\ \Omega$  load with a single  $5.0\text{ V}$  power supply. In addition, this device features an on-board DTMF generator, call progress detector, and  $2100\text{ Hz}$  answer tone generator. This device also features a three-wire serial interface for a microcontroller.

**MC145446AFW – CCITT V.21**  
Case 751M

This device includes the DTMF generator and call progress tone detector (CPTD) as well as the other circuitry needed for

full-duplex, half-duplex, or simplex 300 baud data communication over a pair of telephone lines. It is intended for use with telemetry system or remote control system applications.

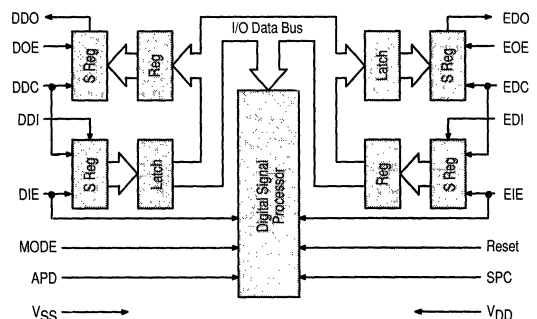
The differential line driver is capable of driving  $0$  dBm into a  $600\ \Omega$  load. The transmit attenuator is programmable in  $1.0\text{ dB}$  steps.

### ADPCM Transcoder

**MC145532DW, L**  
Case 751G, 620

The MC145532 Adaptive Differential Pulse Code Modulation (ADPCM) Transcoder provides a low cost, full-duplex, single-channel transcoder to (from) a  $64\text{ kbps}$  PCM channel from (to) either a  $16\text{ kbps}$ ,  $24\text{ kbps}$ ,  $32\text{ kbps}$ , or  $64\text{ kbps}$  channel.

- Complies with CCITT Recommendation G.721 (1988)
- Complies with the American National Standard (T1.301-1987)
- Full-Duplex, Single-Channel Operation
- Mu-Law or A-Law Coding is Pin Selectable
- Synchronous or Asynchronous Operation
- Easily Interfaces with any Member of Motorola's PCM Codec-Filter Monocircuit Family or Other Industry Standard Codecs
- Serial PCM and ADPCM Data Transfer Rate from  $64\text{ kbps}$  to  $5.12\text{ Mbps}$
- Power Down Capability for Low Cost Consumption
- The Reset State is Automatically Initiated when the Reset Pin is Released.
- Simple Time Slot Assignment Timing for Transcoder Applications
- Single  $5.0\text{ V}$  Power Supply
- Evaluation Kit MC145536 EVK Supports the MC145532 as well as the MC14LC5480 PCM Codec-Filter. (See PBX Architecture Pages for More Information.)



## Telephone Accessory Circuits (continued)

### Calling Line Identification (CLID) Receiver with Ring Detector

#### MC14LC5447P, DW

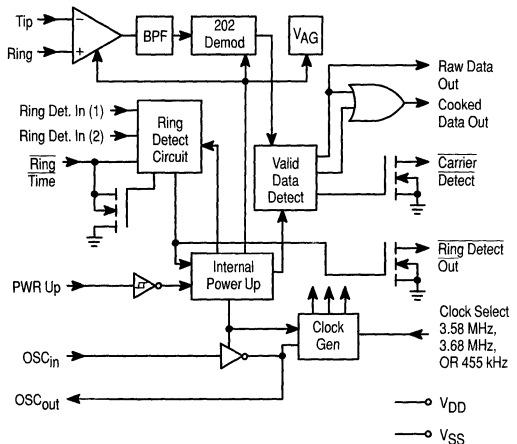
Case 648, 751G

The MC14LC5447 is designed to demodulate Bell 202 1200 baud FSK asynchronous data. Its primary application is in products that will be used to receive and display the calling number, or the message waiting indicator sent to subscribers from participating central office facilities of the public switched telephone network. The device also contains a carrier detect circuit and telephone ring detector which may be used to power up the device.

Applications include adjunct boxes, answering machines, feature phones, fax machines, and computer interface products.

Replaces MC145447P, DW.

- Ring Detector On-Chip
- Ring Detect Output for MCU Interrupt
- Power-Down Mode Less Than 1.0  $\mu\text{A}$
- Single Supply: 3.5 V to 6.0 V
- Pin Selectable Clock Frequencies: 3.68 MHz, 3.58 MHz, or 455 kHz
- Two-Stage Power-Up for Power Management Control

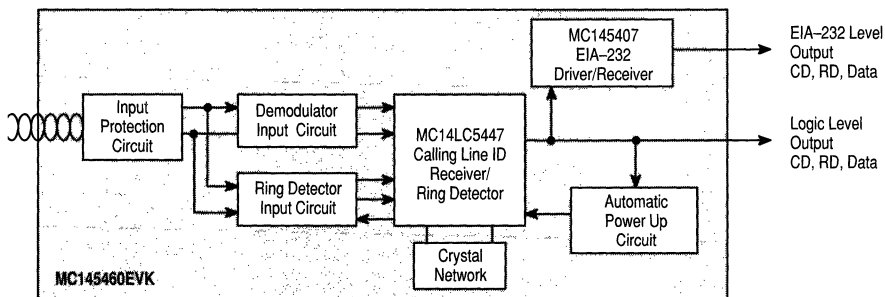


### Calling Line ID Receiver Evaluation Kit

#### MC145460EVK

The MC145460EVK is a low cost evaluation platform for the MC14LC5447. The MC145460EVK facilitates development and testing of products that support the Bellcore customer premises equipment (CPE) data interface, which enables services such as Calling Number Delivery (CND). The MC14LC5447 can be easily incorporated into any telephone, FAX, PBX, key system, answering machine, CND adjunct box or other telephone equipment with the help of the MC145460EVK development kit.

- Easy Clip-On Access to Key MC14LC5447 Signals
- Generous Prototype Area
- Configurable for MC14LC5447 Automatic or External Power Up Control
- EIA-232 and Logic Level Ports for Connection to any PC or MCU Development Platform
- Carrier Detect, Ring Detect and Data Status LEDs
- Optional Tip and Ring Input Protection Network
- MC145460EVK User Guide, MC14LC5447 Data Sheet, and Additional MC14LC5447 Sample Included





## Telephone Accessory Circuits (continued)

**Table 11. Summary of Bipolar Telecommunication Circuits**

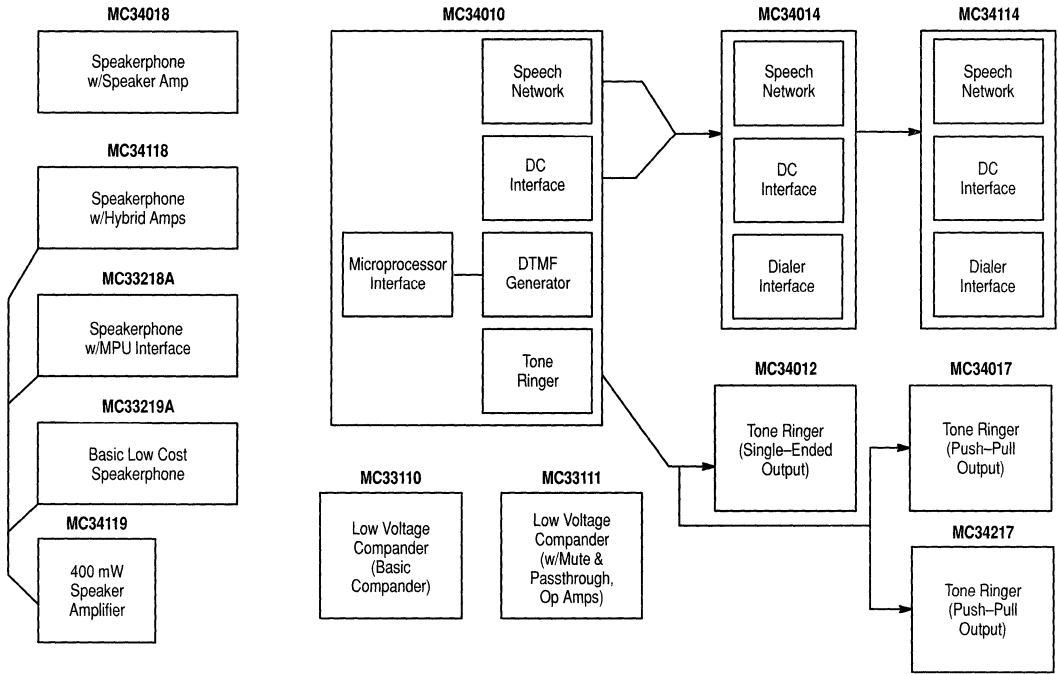
Function	Features	Suffix/ Package	Device
<b>Subscriber Loop Interface Circuits (SLICs)</b>			
Central Office, Remote Terminals, PBX Applications	All gains externally programmable, most BORSHT functions, current limit adjustable to 50 mA, 58 dB Longitudinal Balance, -21.6 V to -42 V.	P/738, FN/776	MC33121
Central Office, Remote Terminals, PBX Applications	All gains externally programmable, most BORSHT functions, current limit adjustable to 50 mA, 58 dB Longitudinal Balance, -42 V to -58 V.	P/738, FN/776	MC33120
<b>Complete Telephone Circuit</b>			
POTS Circuit + MPU Dialing	Speech network, tone ringer, dc loop current interface, DTMF dialer with serial port control.	P/711, FN/777	MC34010
<b>Tone Ringers</b>			
Adjustable Tone Ringer	Single-ended output, meets FCC requirements, adjustable REN, different warble rates.	P/626, D/751	MC34012-1, 2, 3
Adjustable Tone Ringer	Differential output, meets FCC requirements, adjustable REN, different warble rates.	P/626, D/751	MC34017-1, 2, 3
Adjustable Tone Ringer	Differential output, meets FCC requirements, adjustable REN, single warble rates.	P/626, D/751	MC34217
Ring Signal Converter	Switching regulator to convert ringing voltage to regulated dc output. Provides ring detect output.	DP/626, FP/751	TCA3385
<b>Speech Networks</b>			
Speech Network + Speakerphone	Line powered IC provides handset and speakerphone modes, dialer interface, ac/dc terminations, and AGC. Efficient supply design provides 90% of loop current to the speaker amplifier. Speaker amplifier may be used independently. Handset operation to 4.0 mA.	B/858, FB/848B	MC33215
Basic Phone Line Interface	Loop current interface, speech network, line length compensation, speech/dialing modes, Bell System compliant.	P/707, DW/751D	MC34014
Cordless Universal Telephone Interface	For cordless telephone base for CT0, CT1, CT2 and DECT. European dc masks, double wheatstone bridge sidetone circuit. SPI port for masks, AGC hookswitch, mute and gain settings. Requires 5.0 V and $\mu$ P.	P/738, DW/751D	MC34016
Basic Phone Line Interface	Loop current interface, speech network, line length compensation, speech/dialing modes, Bell System and foreign countries.	P/707, DW/751D	MC34114
Programmable Telephone Line Interface Circuit with Loudspeaker Amplifier	Group listening-in, DTMF and tones generator, ring generator, country programmable, SPI interface.	DW/751F	MC34216
European Speech Network, Programmable Speaker Amplifier	Line powered. European dc masks, DTMF and pilot tone generator, listening-in mode with anti-howling. 2-wire bus control masks, DTMF tones, speaker gain, pulse dialing, mute, AGC. Requires MCU.	DW/751	MC34216A
European Speech Network	Loop current interface, speech network, line length compensation, speech/dialing modes, programmable masks for French, U.K., low voltage and PABX systems.	DP/738, FP/751	TCA3388

## Telephone Accessory Circuits (continued)

### Summary of Bipolar Telecommunications Circuits (continued)

Function	Features	Suffix/ Package	Device
<b>Speakerphone Circuits</b>			
Speech Network + Speakerphone	Line powered IC provides handset and speakerphone modes, dialer interface, ac/dc terminations, and AGC. Efficient supply design provides 90% of loop current to the speaker amplifier. Speaker amplifier may be used independently. Handset operation to 4.0 mA.	B/858, FB/848B	MC33215
Complete Speaker Phone with Speaker Amplifier	All level detection (2 pt.), attenuators, and switching controls, mike and speaker amp.	P/710, DW/751F	MC34018
Complete Speaker Phone with Hybrid, Filter	All level detection (4 pt.), attenuators, and switching controls, mike amp with mute, hybrid, and filter.	P/710, DW/751F	MC34118
Complete Speaker Phone with MPU Interface	All level detection, attenuators, and switching controls, mike amp, MPU interface for: volume control, mode selection, mike mute.	P/724, DW/751E	MC33218A
Basic Low Cost Speakerphone	All level detection, attenuators and switching controls, Mike amplifier with Mute, low voltage operation.	P/724, DW/751E	MC33219A
<b>Audio Amplifiers</b>			
1 Watt Audio Amp	1.0 W output power into 16 $\Omega$ , 35 V maximum.	D/751	MC13060
Low Voltage Audio Amp	400 mW, 8.0 to 100 $\Omega$ , 2.0 to 16 V, differential outputs, chip-disable input pin.	P/626, D/751	MC34119
<b>Companders</b>			
Basic Compander	2.1 V to 7.0 V, no precision externals, 80 dB range, $-40^\circ$ to $+85^\circ\text{C}$ , independent compressor and expander.	P/646, D/751A	MC33110
Compander with Features	3.0 V to 7.0 V, no precision externals, 80 dB range, $-40^\circ$ to $+85^\circ\text{C}$ , independent compressor and expander, pass through and mute functions, two op amps.	P/648, D/751B	MC33111
<b>Switching Regulator</b>			
Current Mode Regulator	For phone line power applications, soft-start, current limiting, 2% accuracy.	P/646, D/751A	MC34129
<b>Voice Encoder/Decoders</b>			
Continuously Variable Slope Modulator/Demodulator (CVSD)	Telephone quality voice encoding/decoding, variable clock rate, 3-bit coding, for secure communications, voice storage/retrieval, answering machines, $0^\circ$ to $70^\circ\text{C}$ .	P/738, DW/751G	MC34115
	Same as above except 4-bit coding.	P/738, DW/751G	MC3418

**Figure 3. The Motorola Family of Handset Telecom Integrated Circuits**



# Phase-Locked Loop Components

Motorola offers a choice of phase-locked loop components ranging from complete functional frequency synthesizers for dedicated applications to a wide selection of general purpose PLL circuit elements. Technologies include CMOS for lowest

power consumption and bipolar for high speed operation. Typical applications include TV, CATV, radios, scanners, cordless telephones plus home and personal computers.

**Table 12. PLL Frequency Synthesizers**

Frequency (MHz)	Supply Voltage (V)	Nominal Supply Current (mA)	Phase Detector	Standby	Interface	Device	Suffix/ Case			
4 @ 5 V	4.5 to 12	6 @ 5 V	Single-ended 3-state	No	Parallel	MC145106	P/707, DW/751D			
15 @ 5 V	3 to 9	–	Two single-ended 3-state		Serial	MC145149*	P/738, DW/751D			
		7.5 @ 5 V	Analog			MC145159-1	P/738, DW/751D			
20 @ 5 V	3 to 9	7.5 @ 5 V	Single-ended 3-state, double-ended		4-Bit	MC145145-2	P/707, DW/751D			
						MC145146-2	P/738, DW/751D			
						Parallel	MC145151-2	P/710, DW/751F		
							MC145152-2	P/710, DW/751F		
			Double-ended		Serial	MC145155-2	P/707, DW/751D			
						MC145156-2	P/707, DW/751D			
						MC145157-2	P/648, DW/751G			
				MC145158-2		P/648, DW/751G				
			60 @ 3 V	2.5 to 5.5	3 @ 3 V	Two single-ended 3-state	Yes	Parallel	MC145162*	P/648, DW/751G
									MC145165*	P/648, D/751B
60 @ 2 V	1.8 to 3.6	1.5 @ 1.8 V	Parallel	MC145166*	P/648, DW/751G					
60 @ 3 V	2.5 to 5.5	3 @ 3 V		Serial	MC145167*			P/648, DW/751G		
85 @ 3 V	2.5 to 5.5	3 @ 3 V	Parallel	MC145168*	MC145169*				P/648, DW/751G	
				MC145162-1*						
				MC145173				DW/751E		
40/130 @ 5 V	4.5 to 5.5	9 @ 5 V	Single-ended 3-state, Current source/sink	No	Serial			MC145170-1	P/648, D/751B, DT/948C	
100 @ 3 V 185 @ 5 V	2.5 to 5.5	2 @ 3 V 6 @ 5 V								

\* Dual PLL



## Phase-Locked Loop Components (continued)

### PLL Frequency Synthesizers (continued)

Frequency (MHz)	Supply Voltage (V)	Nominal Supply Current (mA)	Phase Detector	Standby	Interface	Device	Suffix/Case
1100	4.5 to 5.5	7 @ 5 V	Current source/sink, double-ended	Yes	Serial	MC145190	F/751J, DT/948D
						MC145191	F/751J, DT/948D
1100	2.7 to 5	6 @ 2.7 V				MC145192	F/751J, DT/948D
1100	2.7 to 5.5	12	Two current source/sink, double-ended			MC145220*	F/803C, DT/948D
1200, 400	1.8 to 3.6	5	Loop 1 = Current source/sink Loop 2 = Three-state			MC145225*	FU/873C
2000	4.5 to 5.5	12 @ 5 V	Current source/sink, double-ended			MC145200	F/751J, DT/948D
2000	4.5 to 5.5	12 @ 5 V				MC145201	F/751J, DT/948D
2000	2.7 to 5.5	4 @ 3 V				MC145202	F/751J, DT/948D
2600, 400	1.8 to 3.6	7				Loop 1 = Current source/sink Loop 2 = Three-state	MC145230*

\* Dual PLL

**NOTE:** Evaluation kits available for the MC145190, MC145191, MC145192, MC145200, MC145201, MC145202, and MC145220. Order part number MC145\_\_EVK.

**Table 13. Phase-Locked Loop Functions**

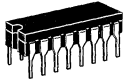
Device	Function	Pins	DIP	SM
MC4016	Programmable Modulo-N Counters (N=0-9)	16	P,L	
MC4018	Programmable Modulo-N Counters (N=0-9)	16	P,L	
MC4024	Dual Voltage-Controlled Multivibrator	14	P,L	
MC4044	Phase-Frequency Detector	14	P,L	D
MC4316	Programmable Modulo-N Counters (N=0-9)	16	P,L	
MC4324	Dual Voltage-Controlled Multivibrator	14	P,L	
MC4344	Phase-Frequency Detector	14	P,L	
MC12002	Analog Mixer	14	P,L	
MC12009	480 MHz +5/6 Dual Modulus Prescaler	16	P,L	
MC12011	550 MHz +8/9 Dual Modulus Prescaler	16	P,L	
MC12013	550 MHz +10/11 Dual Modulus Prescaler	16	P,L	
MC12014	Counter Control Logic	16	P,L	
MC12015	225 MHz +32/33 Dual Modulus Prescaler	8	P,L	D
MC12016	225 MHz +40/41 Dual Modulus Prescaler	8	P,L	D
MC12017	225 MHz +64/65 Dual Modulus Prescaler	8	P,L	D
MC12018	520 MHz +128/129 Dual Modulus Prescaler	8	P,L	D
MC12019	225 MHz +20/21 Dual Modulus Prescaler	8	P,L	D
MC12022A	1.1 GHz +64/65, +128/129 Dual Modulus Prescaler	8	P	D
MC12022B	1.1 GHz +64/65, +128/129 Dual Modulus Prescaler	8	P	D

## Phase-Locked Loop Components (continued)

### Phase-Locked Loop Functions (continued)

Device	Function	Pins	DIP	SM
MC12022LVA	1.1 GHz +64/65, +128/129 Low Voltage Dual Modulus Prescaler	8	P	D
MC12022LVB	1.1 GHz +64/65, +128/129 Low Voltage Dual Modulus Prescaler	8	P	D
MC12022SLA	1.1 GHz +64/65, +128/129 Dual Modulus Prescaler	8	P	D
MC12022SLB	1.1 GHz +64/65, +128/129 Dual Modulus Prescaler	8	P	D
MC12022TSA	1.1 GHz +64/65, +128/129 Dual Modulus Prescaler	8	P	D
MC12022TSB	1.1 GHz +64/65, +128/129 Dual Modulus Prescaler	8	P	D
MC12022TVA	1.1 GHz +64/65, +128/129 Low Voltage Dual Modulus Prescaler	8	P	D
MC12022TVB	1.1 GHz +64/65, +128/129 Low Voltage Dual Modulus Prescaler	8	P	D
MC12023	225 MHz +64 Prescaler	8	P	D
MC12025	520 MHz +64/65 Dual Modulus Prescaler	8	P	D
MC12026A	1.1 GHz +8/9, +16/17 Dual Modulus Prescaler	8	P	D
MC12026B	1.1 GHz +8/9, +16/17 Dual Modulus Prescaler	8	P	D
MC12028A	1.1 GHz +32/33, +64/65 Dual Modulus Prescaler	8	P	D
MC12028B	1.1 GHz +32/33, +64/65 Dual Modulus Prescaler	8	P	D
MC12031A	2.0 GHz +64/65, +128/129 Low Voltage Dual Modulus Prescaler	8	P	D
MC12031B	2.0 GHz +64/65, +128/129 Low Voltage Dual Modulus Prescaler	8	P	D
MC12032A	2.0 GHz +64/65, +128/129 Dual Modulus Prescaler	8	P	D
MC12032B	2.0 GHz +64/65, +128/129 Dual Modulus Prescaler	8	P	D
MC12033A	2.0 GHz +32/33, +64/65 Low Voltage Dual Modulus Prescaler	8	P	D
MC12033B	2.0 GHz +32/33, +64/65 Low Voltage Dual Modulus Prescaler	8	P	D
MC12034A	2.0 GHz +32/33, +64/65 Dual Modulus Prescaler	8	P	D
MC12034B	2.0 GHz +32/33, +64/65 Dual Modulus Prescaler	8	P	D
MC12036A	1.1 GHz +64/65, +128/129 Dual Modulus Prescaler with Stand-By Mode	8	P	D
MC12036B	1.1 GHz +64/65, +128/129 Dual Modulus Prescaler with Stand-By Mode	8	P	D
MC12040	Phase-Frequency Detector	14	P,L	FN
MC12061	Crystal Oscillator	16	P,L	
MC12073	1.1 GHz +64 Prescaler	8	P	D
MC12074	1.1 GHz +256 Prescaler	8	P	D
MC12076	1.3 GHz +256 Prescaler	8	P	D
MC12078	1.3 GHz +256 Prescaler	8	P	D
MC12079	2.8 GHz +64/128/256 Prescaler	8	P	D
MC12080	1.1 GHz +10/20/40/80 Prescaler	8	P	D
MC12083	1.1 GHz +2 Low Power Prescaler with Stand-By Mode	8	P	D
MC12089	2.8 GHz +64/128/256 Low Power Prescaler	8	P	D
MC12090	750 MHz +2 UHF Prescaler	16	P,L	
MC12100	200 MHz Voltage Controlled Multivibrator	20	P	FN
MC12101	130 MHz Voltage Controlled Multivibrator	20	P	FN
MCH12140	Phase-Frequency Detector	8		D
MCK12140	Phase-Frequency Detector	8		D
MC12148	Low Power Voltage Controlled Oscillator	8		D,SD

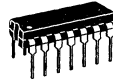
# Communications Circuits Package Overview



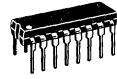
CASE 620  
L SUFFIX



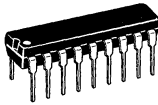
CASE 626  
P SUFFIX



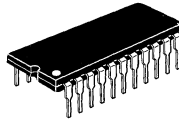
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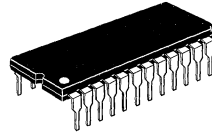
CASE 648  
P SUFFIX



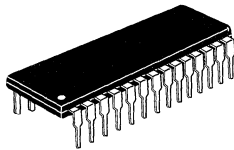
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P SUFFIX



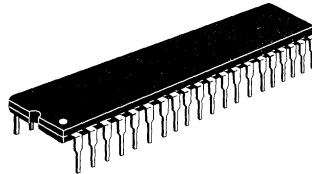
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P SUFFIX



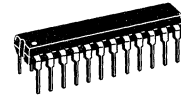
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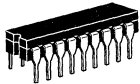
CASE 710  
P SUFFIX



CASE 711  
P SUFFIX



CASE 724  
P SUFFIX



CASE 726  
L SUFFIX



CASE 738  
DP, P SUFFIX



CASE 751  
D, D1 SUFFIX



CASE 751A  
D SUFFIX



CASE 751B  
D SUFFIX



CASE 751D  
DW, FP SUFFIX



CASE 751E  
DW SUFFIX



CASE 751F  
DW SUFFIX

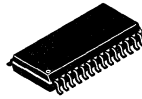
Communications Circuits Package Overview (continued)



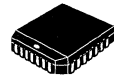
CASE 751G  
DW SUFFIX



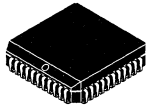
CASE 751J  
F SUFFIX



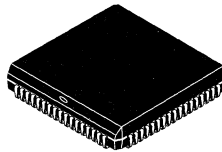
CASE 751M  
FW SUFFIX



CASE 776  
FN SUFFIX



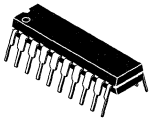
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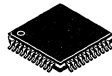
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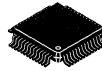
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F SUFFIX



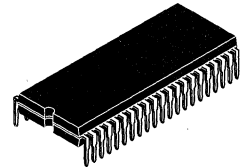
CASE 804  
H SUFFIX



CASE 824D  
PB SUFFIX



CASE 848B  
FB SUFFIX



CASE 858  
B SUFFIX



CASE 873  
FB, FTB, FU SUFFIX



CASE 873A  
PB SUFFIX



CASE 873C  
FU SUFFIX



CASE 932  
FTA SUFFIX



CASE 940C  
SD SUFFIX



CASE 948C  
DT SUFFIX



CASE 948D  
DT SUFFIX



CASE 948F  
DTB SUFFIX



CASE 976  
FTB SUFFIX



CASE 977  
FTA SUFFIX

# Consumer Electronic Circuits

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## In Brief . . .

These integrated circuits reflect Motorola's continuing commitment to semiconductor products necessary for consumer system designs. This tabulation is arranged to simplify selection of consumer integrated circuit devices that satisfy the primary functions for home entertainment products, including television, hi-fi audio and AM/FM radio.

	<b>Page</b>
Entertainment Radio Receiver Circuits . . . . .	4.8-2
Entertainment Receiver RF/IF . . . . .	4.8-2
C-Quam® AM Stereo Decoders . . . . .	4.8-2
Audio Amplifiers . . . . .	4.8-2
Video Circuits . . . . .	4.8-3
Encoders . . . . .	4.8-3
TV Decoder . . . . .	4.8-3
Video Capture Chip Sets . . . . .	4.8-3
TV Picture-in-Picture . . . . .	4.8-3
Comb Filters . . . . .	4.8-3
Deflection . . . . .	4.8-3
TV IF Circuits . . . . .	4.8-3
Tuner PLL Circuits . . . . .	4.8-4
Modulator . . . . .	4.8-4
Video Data Converters . . . . .	4.8-4
Monitor Subsystem . . . . .	4.8-4
Miscellaneous . . . . .	4.8-4
Circuit Descriptions and Diagrams . . . . .	4.8-6
Package Overview . . . . .	4.8-24

# Entertainment Radio Receiver Circuits

**Table 1. Entertainment Receiver RF/IF**

Function	Features	Suffix/ Package	Device
E.T.R. Front End	Mixer/VCO/AGC for Electronically Tuned AM Stereo Receivers	P/648, D/751B	MC13025
AMAX Front End	Mixer/VCO/AGC with RF and Audio Noise Blanking	DW/751D, P/738	MC13027
Dual Conversion AM Receiver	1st Mixer/OSC, 2nd Mixer/OSC, High Gain IF, AGC, Detector	DW/751F	MC13030

**Table 2. C-Quam® AM Stereo Decoders**

Function	Features	Suffix/ Package	Device
Advanced AM Stereo Decoder	Medium Voltage 6.0 to 10 V, Decoder and IF Amp	P/710, DW/751F	MC13022A
Low V AM Stereo Receiver	IF/Decoder for Advanced C-Quam Receivers	P/648, D/751B	MC13028A
Medium V AM Stereo Decoder	IF/Decoder for Advanced C-Quam Receivers with AM/FM Switch	DW/751D, H/738	MC13029A
AMAX Stereo Decoder	Am Stereo Decoder with Audio Noise Blanker	DW/751F, P/710	MC13122

**Table 3. Audio Amplifiers**

Function	P <sub>O</sub> (Watts)	V <sub>CC</sub> Vdc Max	V <sub>in</sub> @ Rated P <sub>O</sub> mV Typ	I <sub>D</sub> mA Typ	R <sub>L</sub> (Ohms)	Suffix/ Package	Device
Mini Watt SOIC Audio Amp	1.0 W	35	80	11	16	D/751	MC13060
Low Power Audio Amp	500 mW	16	–	2.5 mA	8 – ∞	D/751, P/626, DTB/948J	MC34119

# Video Circuits

**Table 4. Video Circuits**

Function	Features	Suffix/ Package	Device
<b>Encoders</b>			
Video Overlay Synchronizer	Complete Color TV Video Overlay Synchronizer, remote or local system control and RGB encoder.	P/711, FN/777	MC1378
Advanced RGB to PAL/NTSC Encoder	RGB and Sync inputs, Composite Video and S-VHS out; PAL/NTSC selectable; subcarrier from crystal or external source.	P/738, DW/751D	MC13077
<b>TV Decoder</b>			
Chroma 4 Multistandard Decoders (TV Set)	PAL/NTSC/SECAM decoding, Composite Video/S-VHS Inputs, RGB Outputs, horizontal and vertical drive outputs, geometry correction and beam current monitor, digital internal filters, no external tank, 16:9 capability, $\mu$ P and crystal controlled.	P/711	MC44002
	Same as MC44002, but without SECAM decoding.	P/711	MC44007
	Same as MC44002, but with internal chroma delay line.	P/711	MC44030
	Same as MC44030, but without SECAM decoding.	P/711	MC44035
<b>Video Capture Chip Sets</b>			
Chroma 4 Multistandard Video Processor (Multimedia)	PAL/NTSC/S-VHS input, RGB/YUV outputs; horizontal and vertical timing outputs; all digital internal filters, no external tanks; $\mu$ P and crystal controlled.	FN/777, FB/824E	MC44011
Chroma Digital Delay Line	For PAL and SECAM applications of the MC44011, MC44002, MC44007.	P/648, DW/751G	MC44140
Pixel Clock PLL/Sync Sep.	PAL/NTSC sync separator, 6.0–40 MHz pixel clock PLL.	D/751A	MC44145
Triple 8-Bit Video DAC	TTL inputs, 75 $\Omega$ drive outputs.	FB/824A	MC44200
Triple 8-Bit Video A/D	Video clamps for RGB/YUV, 18 MHz, High Z TTL outputs.	FN/777, FU/824A	MC44251
<b>TV Picture-in-Picture</b>			
Picture-in-Picture (PIP) Controller	Completely self-contained NTSC picture-in-picture function.	B/859	MC44461
Y-C Picture-in-Picture (PIP) Controller	Completely self-contained NTSC picture-in-picture function, with Y-C input and output capability, for use in high performance S-Video systems.	B/859	MC44462
Replay and Multiple Picture-in-Picture (PIP) Controller	Offers either multiple PIP windows or several seconds of replay. Used with external DRAM.	B/859	MC44463
<b>Comb Filters</b>			
Enhanced Comb Filter	Fast 8-Bit A/D Converter, Two 8-Bit D/A Converters, Two Line-Delay Memories, utilizes NTSC Subcarrier Frequency clock, CMOS Technology.	FU/898	MC141620
Advanced Comb Filter (ACF)	Composite Video input; YC outputs in digital and analog form; all digital internal filters.	FU/898	MC141621A
Advanced Comb Filter – II (ACF-II)	Composite Video input; YC outputs in digital and analog form; all digital internal filters; vertical enhancer circuit.	P/898	MC141622A
Advanced Comb Filter – I (ACF-I)	Low cost 1h filter.	FU/873 SP/TBD	MC141624
Advanced PAL/NTSC Comb Filter	Composite Video input; YC outputs in digital and analog form; all digital internal filters.	FB/898	MC141627
<b>Deflection</b>			
Horizontal Processor	Linear balanced phase detector, oscillator and predriver, adjustable DC loop gain and duty cycle.	P/626	MC1391
<b>TV IF Circuits</b>			
IF Amplifier	1st and 2nd video IF amplifiers, 50 dB gain at 45 MHz, 60 dB AGC range.	D/751, P/626	MC1350

**Table 4. Video Circuits (continued)**

Function	Features	Suffix/ Package	Device
<b>Tuner PLL Circuits</b>			
PLL Tuning Circuits	1.3 GHz, 10 mV sensitivity selectable prescaler (MC44817), op amp, 4 band buffers, 3–wire bus interface, lock detect.	D/751B	MC44817, B
	1.3 GHz, 10 mV sensitivity prescaler, op amp, 4 band buffers, I <sup>2</sup> C interface, lock detect.	D/751B	MC44818
	1.3 GHz, 10 mV sensitivity prescaler, 3 band buffers, I <sup>2</sup> C interface, replacement for Siemens MPG3002.	D/751, D/751B	MC44824, MC44825
	Similar to MC44817, with lower power consumption, push–pull lock detector output, no divide–by–8 bypass, in a TSSOP package.	DTB/948F	MC44827
	Similar to MC44818, with lower power consumption, push–pull lock detector output, in a TSSOP package.	DTB/948F	MC44828
	1.3 GHz prescaler, 10 mV sensitivity 50 to 950 MHz, op amp, 3 band buffers, Mixer/Osc Decoder and I <sup>2</sup> C Bus.	D/751A	MC44829
	1.3 GHz, 10 mV sensitivity selectable prescaler, op amp, 4 band buffers, I <sup>2</sup> C interface, 3 DACs for automatic tuner alignment.	M/967	MC44864
<b>Modulator</b>			
Color TV Modulator with Sound	RF oscillator/modulator, and FM sound oscillator/modulator.	P/646	MC1374
UHF TV Modulator	Multi–standard PLL tuned UHF TV modulator with AM or FM sound.	DTB/948E, DW/751D	MC44353, MC44354, MC44355
<b>Video Data Converters</b>			
Single Channel A/D	8–Bit, 25 MHz, 2.0 V input range, ±5.0 V supplies, TTL output, no pipeline delay.	P/709, DW/751E	MC10319
Triple 8–Bit Video A/D	Video clamps for RGB/YUV, 18 MHz conversion, high Z outputs.	FN/777, FU/824A	MC44251
Triple 8–Bit Video DAC	TTL inputs, 75 Ω drive outputs.	FB/824	MC44200
<b>Monitor Subsystem</b>			
Multimode Color Monitor Processor	Adaptable to 30 kHz to 64 kHz horizontal, 45 to 100 Hz vertical frequency, multiple sync including sync–on–green, horizontal and vertical drive outputs, double PLL, 70 MHz RGB pre–amps, contrast and brightness controls.	B/859	MC13081X
RGB Video Processor	80 MHz bandwidth, blank and clamp inputs, main contrast and subcontrast controls.	P/738	MC13280AY
	Same as above, except 100 MHz bandwidth.	P/738	MC13281B
	Same as above, except 100 MHz bandwidth and pin compatible with MC13282A.	P/724	MC13281A
RGB Video Processor with OSD Inputs	100 MHz bandwidth, blank and clamp inputs, main contrast and subcontrast controls, OSD inputs, OSD contrast control, pin compatible with MC13281A.	P/724	MC13282A
	Same as above, except 130 MHz bandwidth.	P/724	MC13283
<b>Miscellaneous</b>			
Subcarrier Reference Generator	Provides continuous subcarrier sine wave and 4x subcarrier, locked to incoming burst.	P/626, D/751	MC44144
Closed Caption Decoder	Conforms to FCC, NTSC standards, underline and italics control.	P/707	MC144143
Enhanced Closed Caption Decoder	Conforms to FCC, NTSC, XDS standards, underline, italics and OSC.	P/707	MC144144
Sync Separator/Pixel Clock PLL	PAL/NTSC sync separator with vertical and composite sync output, 6 to 40 MHz pixel clock PLL.	D/751A	MC44145
Dual Video Amplifiers	Gain @ 4.43 MHz = 6.0 dB ±1.0 dB, fixed gain, internally compensated, CMOS Technology.	P/626, F/904	MC14576C
	Gain @ 5.0 MHz = 10 dB max, 10 MHz = 6.0 dB max, adjustable gain, internally compensated, CMOS Technology.	P/626, F/904	MC14577C
Transistor Array	One differential pair and 3 isolated transistors, 15 V, 50 mA.	P/646, D/751A	MC3346



**Table 5. Video Decoders**

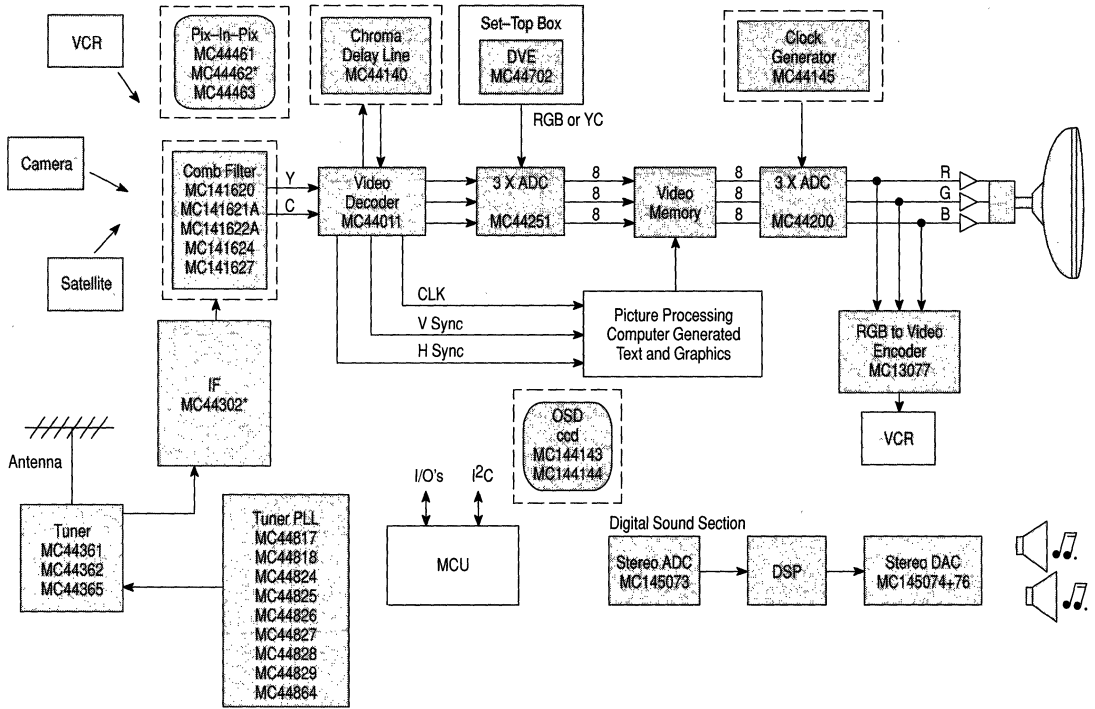
Function	MC44002	MC44007	MC44030(1)	MC44035	MC44011
For TV Set Applications (RGB Outputs for CRT Driver)	Yes		Yes		No
For Video Capture Applications (RGB/YUV Outputs)	No		No		Yes
PAL/NTSC Decoding	Yes		Yes		Yes
SECAM Decoding	Yes	No	Yes	No	No
Chroma Delay Line	External		Internal		External
Composite Video Inputs	2		2		2
Y/C Inputs	1 set (Note 2)		1 set (Note 2)		1 set (Note 2)
RGB Inputs (3 Pins)	1 set		1 set		1 set
YUV Outputs/Inputs	Yes		Yes		Yes
Video Output for Teletext or Closed Caption	No		No		No
16:9 Capability on 4:3 Screen	Yes		Yes		No
Single 5.0 V Supply	Yes		Yes		Yes
Supply Current (Typical)	120 mA		150 mA		110 mA
Video Mute (Blanking Control)	No		Yes		No
Pixel Clock Generator for A/D	No		No		Yes

**NOTES:** 1. The MC44030 with integrated chroma delay line can replace the MC44002 + MC44140. A single PC board pattern can be made to accept either device and the software can be written to be compatible, although the MC44030 has several additional functions.

2. In Y/C mode the two CVBS inputs become Y and C inputs.

3. One set uses SCART Video input as Y and SCART Red input as C. The second set are independent inputs.

Video Capture Block Diagram



\* In Development

## Digitally Controlled Video Processor for Multimedia Applications

MC44011FN, FB

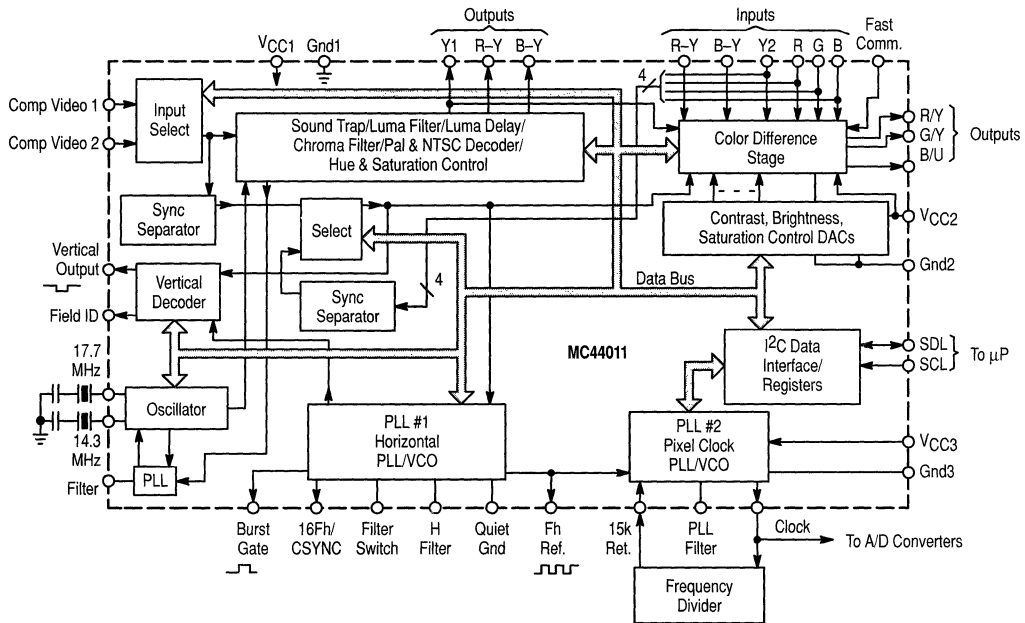
Case 777, 824E

The MC44011, a member of the MC44xxx Chroma 4 family, is designed to provide RGB or YUV outputs from a variety of inputs. The inputs may be either PAL or NTSC composite video (two inputs), S-VHS, RGB, and color difference (R-Y, B-Y).

The MC44011 provides a sampling clock output for use by a subsequent analog to digital converter. The sampling clock (6.0 to 40 MHz) is phase-locked to the horizontal frequency. Additional outputs include composite sync, vertical sync, field identification, luminance, burst gate, and horizontal frequency.

Control of the MC44011, and reading of status flags is accomplished via an I<sup>2</sup>C bus.

- Multistandard Decoder, Accepts NTSC and PAL Composite Video
- Dual Composite Video or S-VHS Inputs
- All Chroma and Luma Channel Filtering, and Luma Delay Line are Integrated Using Sampled Data Filters Requiring no External components
- Digitally Controlled via I<sup>2</sup>C Bus
- Auxiliary Y, R-Y, B-Y Inputs
- Switched RGB Inputs with Separate Saturation Control
- Line-Locked Sampling Clock for Digitizing Video Signals
- Burst Gate Pulse Output for External Clamping
- Vertical Sync and Field Ident Outputs
- Software Selectable YUV or RGB Outputs Able to Drive A/D Converters



## Triple 8-Bit D/A Converter

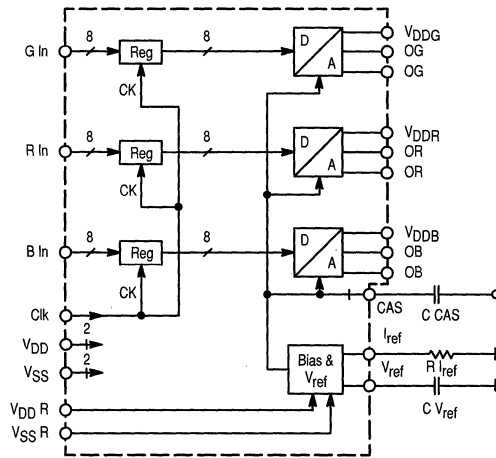
### MC44200FB

Case 824A

The MC44200 is a monolithic digital to analog converter for three independent channels fabricated in CMOS technology. The part is specifically designed for video applications. Differential outputs are provided, allowing for a large output voltage range.

- 8-Bit Resolution
- Differential Outputs

- 55 msp/s Conversion Speed
- Large Output Voltage Range
- Low Current Mode
- Single 5.0 V Power Supply
- TTL Compatible Inputs
- Integrated Reference Voltage



## Video Circuits (continued)

### Triple 8-Bit A/D Converter

MC44251FN, FU

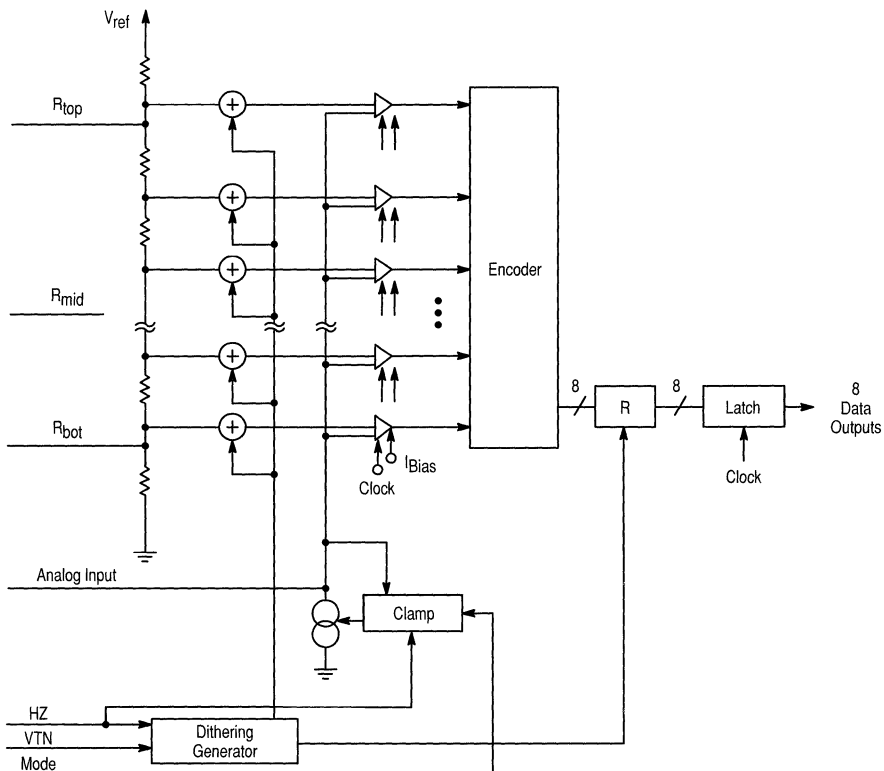
Case 777, 824A

The MC44251 contains three independent parallel analog to digital converters. Each ADC consists of 256 latching comparators and an encoder. Input clamps allow for AC coupling of the input signals, and dc coupling is also allowed. For video processing performance enhancements, a dither generator with subsequent digital correction is provided to each ADC. The outputs of the MC44251 can be set to a high impedance state.

These A/Ds are especially suitable as front end converters in TV picture processing.

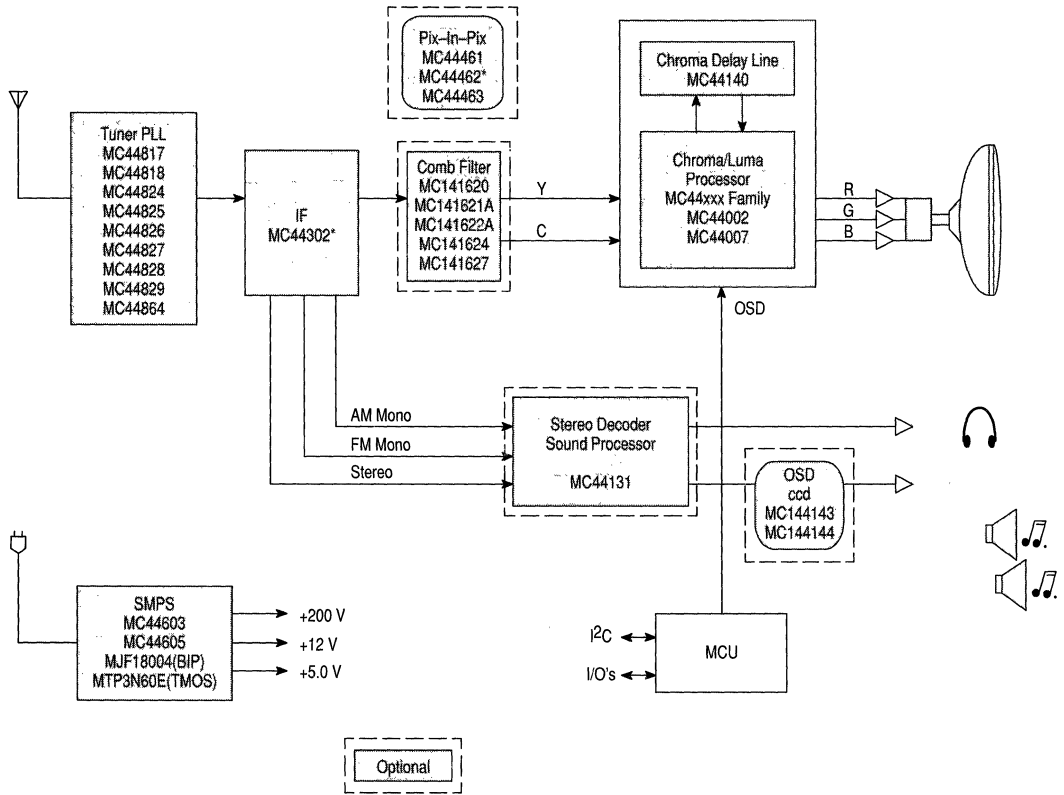
- 18 MHz Maximum Conversion Speed (MC44251)
- Input Clamps Suitable for RGB and YUV Applications
- Built-in Dither Generator with Subsequent Digital Correction
- Single 5.0 V Power Supply

Simplified Diagram of One of the ADCs



# Video Circuits (continued)

## Color TV Block Diagram



\* In Development

## Multistandard Video/Timebase Processor

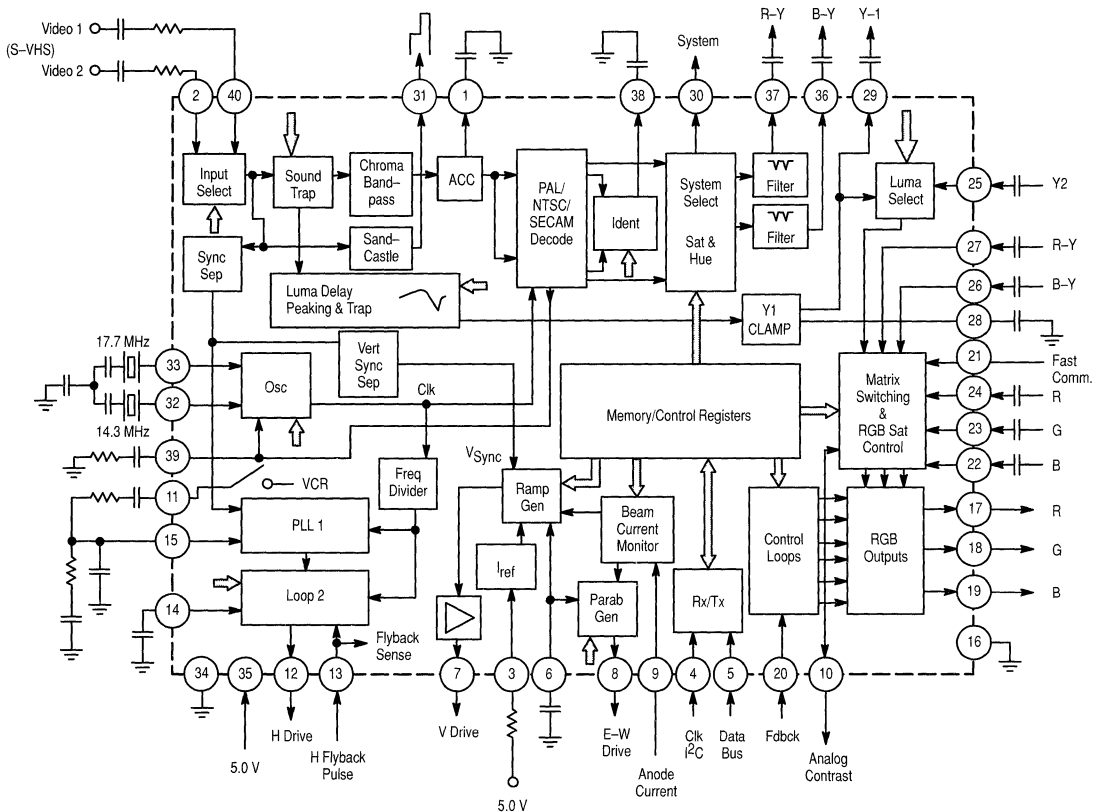
MC44002P, MC44007P

Case 711

The MC44002/7 is a highly advanced circuit which performs most of the basic functions required for a color TV. All of its advanced features are under processor control via an I<sup>2</sup>C bus, enabling potentiometer controls to be removed completely. In this way the component count may be reduced dramatically to allow significant cost savings and the possibility of implementing sophisticated automatic test routines. Using the MC44002/7, TV manufacturers will be able to build a standard chassis for anywhere in the world.

- Operation from a Single 5.0 V Supply; Typical Current Consumption Only 120 mA
- Full PAL/SECAM/NTSC Capability (MC44002 Only)
- MC44007 Decodes PAL/NTSC Only
- Dual Composite Video or S-VHS Inputs
- All Chroma/Luma Channel Filtering, and Luma Delay Line are Integrated Using Sampled Data Filters Requiring No External Components

- Filters Automatically Commutate with Change of Standard
- Chroma Delay Line is Realized with Companion Device (MC44140)
- RGB Drives Incorporate Contrast and Brightness Controls and Auto Gray Scale
- Switched RGB Inputs with Saturation Control
- Auxiliary Y, R-Y, B-Y Inputs
- Line Timebase Featuring H-Phase Control and Switchable Phase Detector Gain and Time Constant
- Vertical Timebase Incorporating the Vertical Geometry Corrections
- E-W Parabola Drive Incorporating the Horizontal Geometry Corrections
- Beam Current Monitor with Breathing Compensation
- 16:9 Display Mode Capability



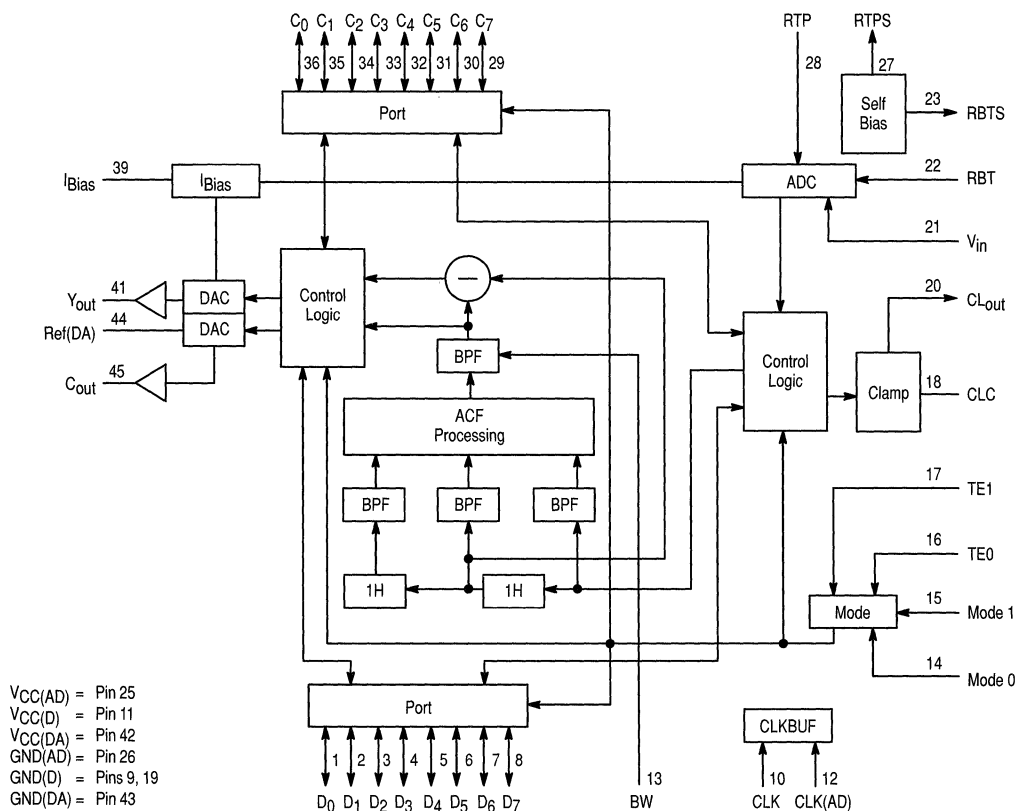
## Advanced NTSC Comb Filter

### MC141621FB

Case 898

The MC141621 is an advanced NTSC comb filter for VCR and TV applications. It separates the luminance (Y) and chrominance (C) signals from the NTSC composite video signal by using digital signal processing techniques. This filter allows a video signal input of an extended frequency bandwidth by using a 4.0 F<sub>SC</sub> clock. In addition, the filter minimizes dot crawl and cross color effects. The built-in A/D and D/A converters allow easy connections to analog video circuits.

- Built-in High Speed 8-Bit A/D Converter
- Two Line Memories (1820 Bytes)
- Advanced Combing Process
- Two 8-Bit D/A Converters
- Built-in Clamp Circuit
- On-Chip Reference Voltage Regulator for ADC
- Digital Interface Mode





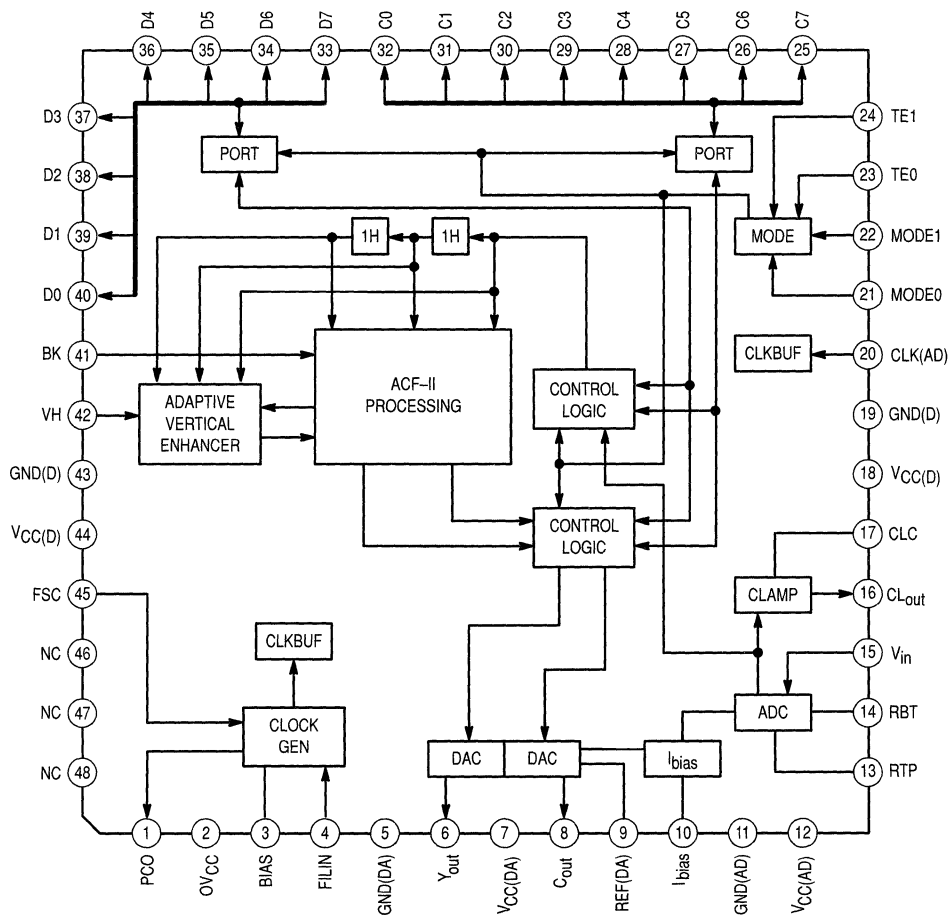
## Advanced Comb Filter-II (ACF-II)

MC141622AFU

Case 898

The Advanced Comb Filter-II is a video signal processor for VCRs and TVs. It's function is to separate the Luminance Y and Chrominance C signals from the NTSC composite video signal. The ACF-II minimizes dot-crawl and cross-color. A built-in PLL provides a 4xfscc clock from either an NTSC subcarrier signal or a 4xfscc input. This allows a video signal input of an extended frequency bandwidth. The built-in vertical enhancer circuit improves the quality of the Luminance Y signal. The built-in A/D and D/A converters allow easy connection to analog video circuits.

- Built-in High Speed 8-Bit A/D Converter
- Two Line Memories (1820 Bytes)
- Advanced Comb-II Process
- Vertical Enhancer Circuit
- Two High Speed 8-Bit D/A Converters
- 4xfscc PLL Circuit
- Built-in Clamp Circuit
- Digital Interface Mode
- On-Chip Reference Voltage Regulator for A/D Converter



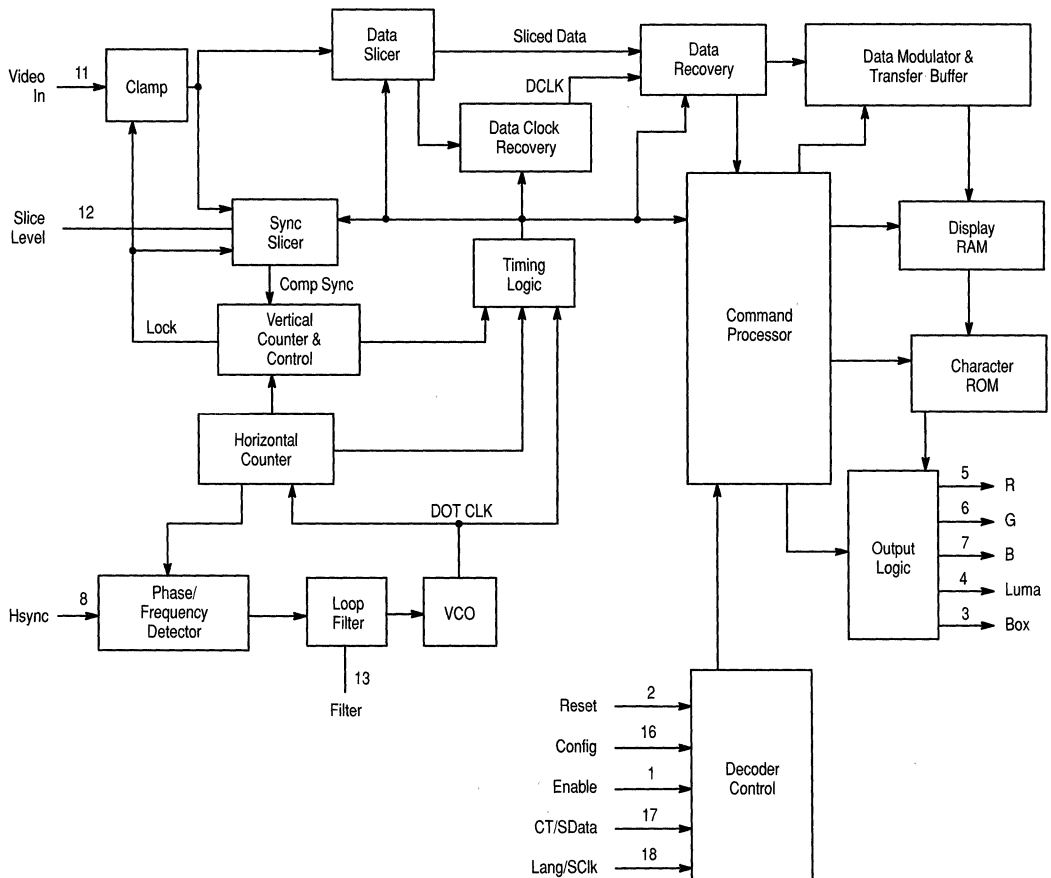
## Closed-Caption Decoder

### MC144143P

Case 707

The MC144143 is a Line 21 closed-caption decoder for use in television receivers or set top decoders conforming to the NTSC broadcast standard. Capability for processing and displaying all of the latest standard Line 21 closed-caption format transmissions is included. The device requires a closed-caption encoded composite video signal, a horizontal sync signal, and an external keyer to produce captioned video. RGB outputs are provided, along with a luminance and a box signal, allowing simple interface to both color and black and white receivers.

- Conforms to the FCC Report and Order as Amended by the Petition for Reconsideration on Gen. Doc. 91-1
- Supports Four Different Data Channels, Time Multiplexed within the Line 21 Data Stream: Captions Utilizing Languages 1 & 2, Plus Text Utilizing Languages 1 & 2
- Output Logic Provides Hardware Underline Control and Italics Slant Generation
- Single Supply Operating Voltage Range: 4.75 to 5.25 V
- Composite Video Input Range: 0.7 to 1.4 V<sub>pp</sub>
- Horizontal Sync Input Polarity can be either Positive or Negative
- Internal Timing/Sync Signals Derived from On-Chip VCO



# Enhanced Closed-Caption Decoder

## MC144144P

Case 707

The MC144144 is a Line 21 closed-caption decoder for use in television receivers or set-top decoders conforming to the NTSC standard. Capability for processing and displaying all of the latest standard Line 21 closed-caption format transmissions is included. The device requires a closed-caption encoded composite video signal, a horizontal sync signal, and an external keyer to produce captioned video. RGB and box signal outputs are provided, which along with the mode select, allow simple interfacing to either color or black-and-white TV receivers.

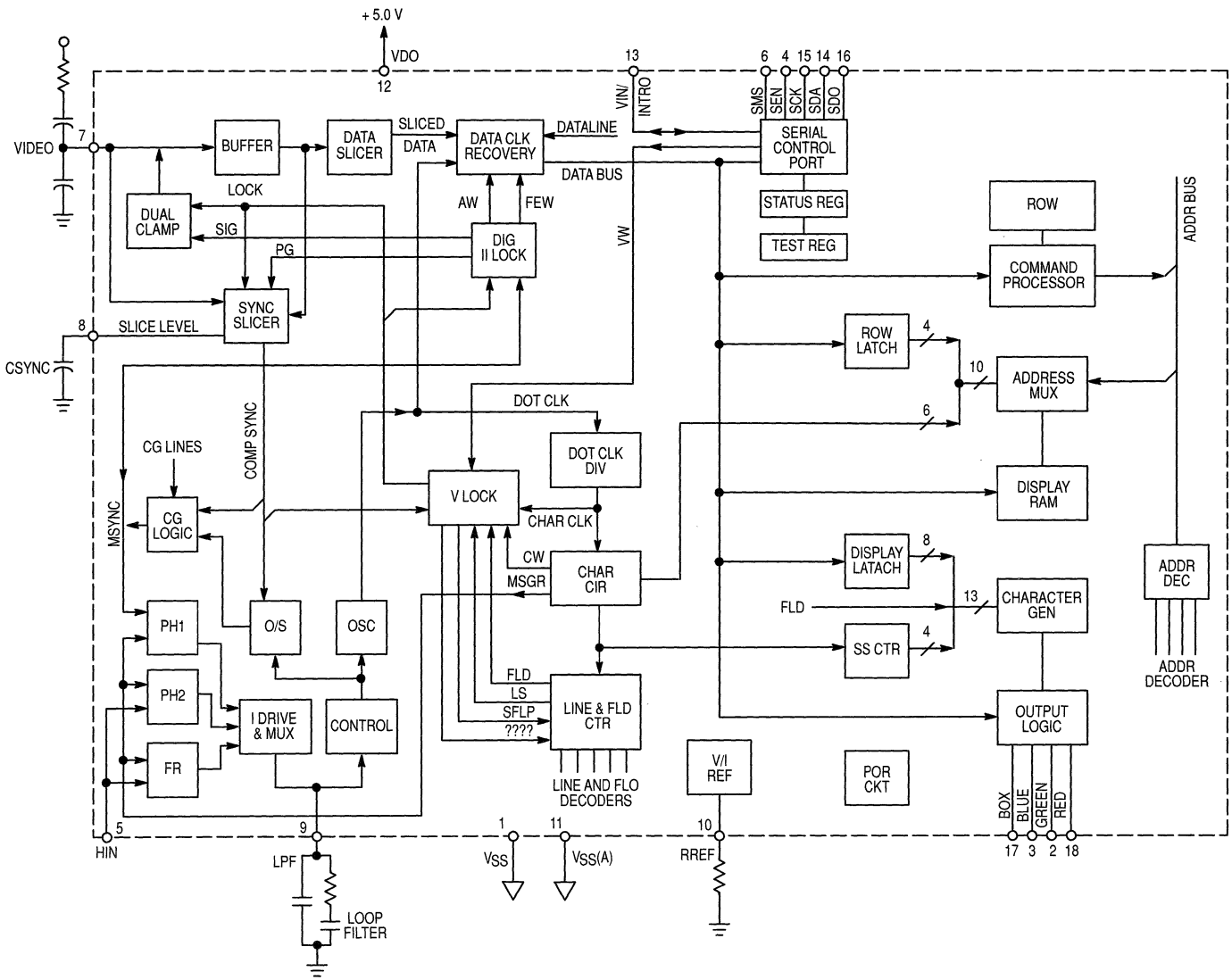
Display storage is accomplished with an on-chip RAM. A modified ASCII character set, which includes several non-English characters, is decoded by an on-chip ROM. An on-screen character appears as a white or colored dot matrix on a black background.

Captions (video-related information) can be up to four rows appearing anywhere on the screen and can be displayed in two modes: roll-up, paint-on, or pop-on. With rollup captions, the row scrolls up and new information appears at the bottom row each time a carriage return is received. Pop-on captions work with two memories. One memory is displayed while the other is used to accumulate new data. A special command causes the information to be exchanged in the two memories, thus causing the entire caption to appear at once.

When text (non-video related information) is displayed, the rows contain a maximum of 32 characters over a black box which overwrites the screen. Fifteen rows of characters are displayed in the text mode.

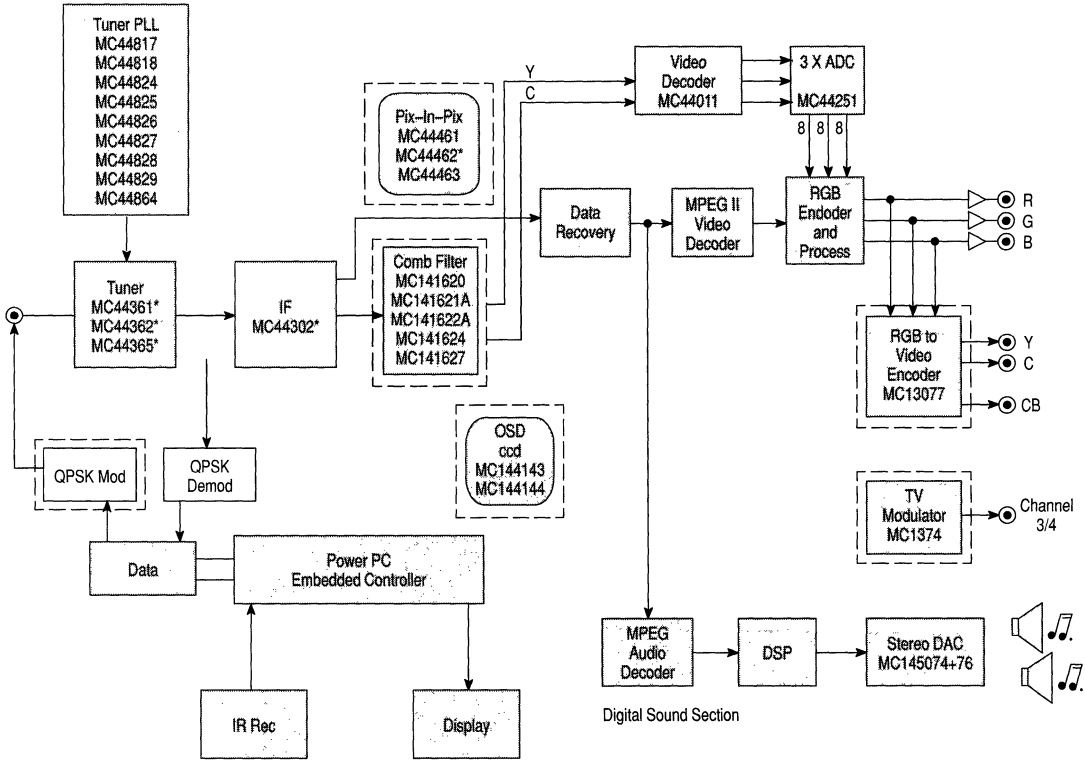
An on-chip processor controls the manipulation of data for storage and display. Also controlled are the loading, addressing, and clearing of the display RAM. The processor transfers the data received to the RAM during scan lines 21 through 42. The operation of the display RAM, character ROM, and output logic circuits are controlled during scan lines 43 through 237. The functions of the MC144144 are controlled via a serial port which may be configured to be either I<sup>2</sup>C or SPI.

- Conforms to FCC Report and Order as Amended by the Petition for Reconsideration on Gen. Doc. 91-1
- Conforms to EIA-608 for XDS Data Structure
- Supports Four Different Data Channels for Field 1 and Five Different Data Channels for Field 2, Time Multiplexed within the Line 21 Data Stream: Captions Utilizing Languages 1 and 2, Text Utilizing Languages 1 and 2 and XDS Support
- Output Logic Provides Hardware Underline Control and Italics Slant Generation
- Single Supply, Operating Voltage Range: 4.75 to 5.25 V
- Supply Current: 20 mA (Preliminary)
- Operating Temperature Range: 0 to 70°C
- Composite Video Input Range: 0.7 to 1.4 V<sub>pp</sub>
- Horizontal Input Polarity: Either Positive or Negative
- Internal Timing and Sync Signals Derived from On-Chip VCO



# Video Circuits (continued)

## Set-Top Block Diagram



\* In Development

## PLL Tuning Circuits with 3-Wire Bus

### MC44817BD, D

Case 751B

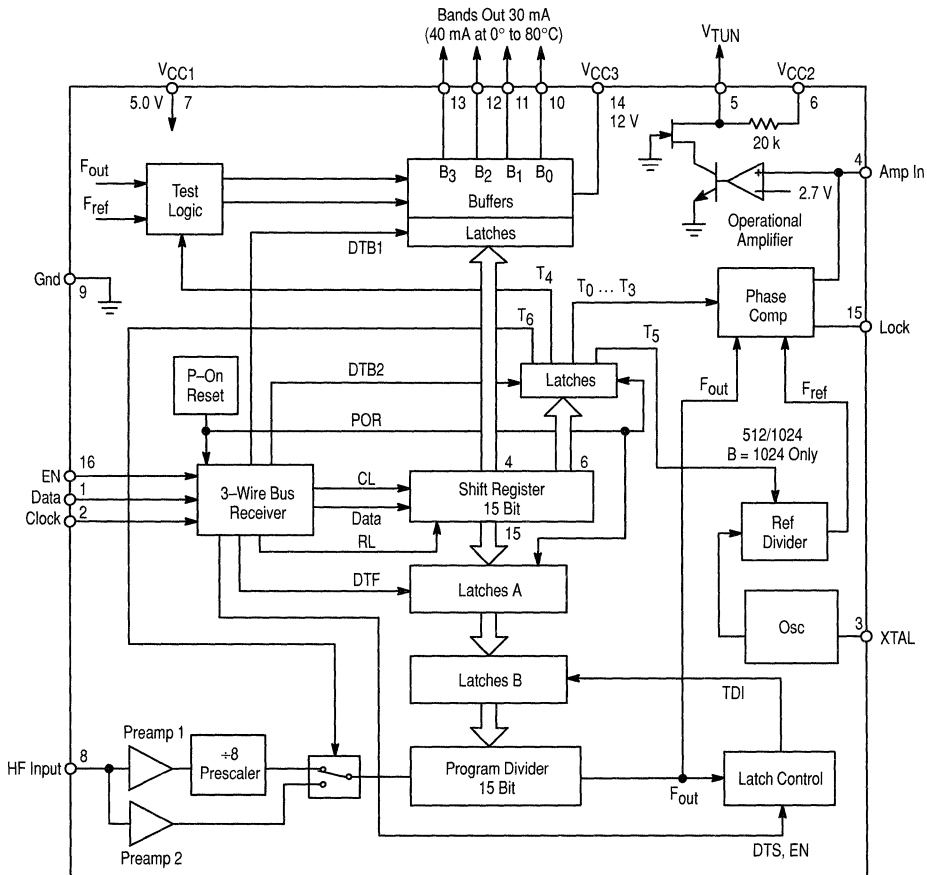
The MC44817/17B are tuning circuits for TV and VCR tuner applications. They contain on one chip all the functions required for PLL control of a VCO. The integrated circuits also contain a high frequency prescaler and thus can handle frequencies up to 1.3 GHz.

The MC44817 has programmable 512/1024 reference dividers while the MC44817B has a fixed reference divider of 1024.

The MC44817/17B are manufactured on a single silicon chip using Motorola's high density bipolar process, MOSAIC™ (Motorola Oxide Self Aligned Implanted Circuits).

- Complete Single Chip System for MPU Control (3-Wire Bus). Data and Clock Inputs are IIC Bus Compatible
- Divide-by-8 Prescaler Accepts Frequencies up to 1.3 GHz
- 15 Bit Programmable Divider Accepts Input Frequencies up to 165 MHz

- Reference Divider: Programmable for Division Ratios 512 and 1024. The MC44817B has a Fixed 1024 Reference Divider
- 3-State Phase/Frequency Comparator
- Operational Amplifier for Direct Tuning Voltage Output (30 V)
- Four Integrated PNP Band Buffers for 40 mA ( $V_{CC1}$  to 14.4 V)
- Output Options for the Reference Frequency and the Programmable Divider
- Bus Protocol for 18 or 19 Bit Transmission
- Extra Protocol for 34 Bit for Test and Further Features
- High Sensitivity Preamplifier
- Circuit to Detect Phase Lock
- Fully ESD Protected



## PLL Tuning Circuit with I<sup>2</sup>C Bus

### MC44818D

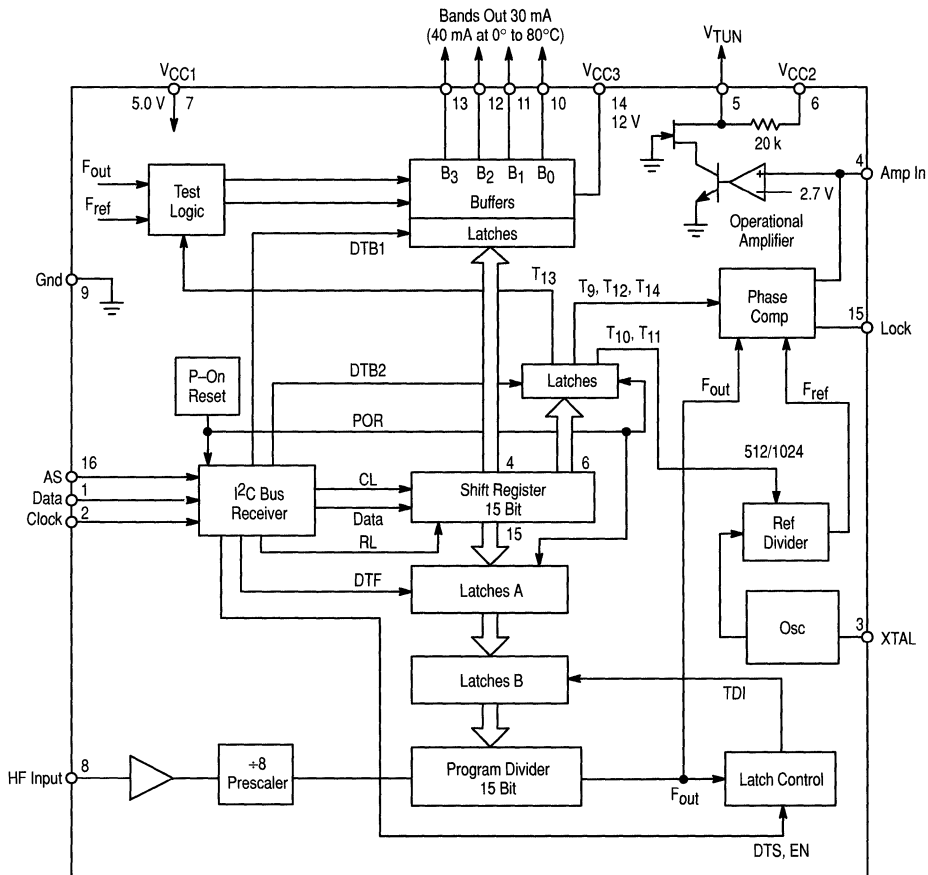
Case 751B

The MC44818 is a tuning circuit for TV and VCR tuner applications. It contains, on one chip, all the functions required for PLL control of a VCO. This integrated circuit also contains a high frequency prescaler and thus can handle frequencies up to 1.3 GHz. The MC44818 is a pin compatible drop-in replacement for the MC44817, where the only difference is the MC44818 has a fixed divide-by-8 prescaler (cannot be bypassed) and the MC44817 uses the three wire bus.

The MC44818 has programmable 512/1024 reference dividers and is manufactured on a single silicon chip using Motorola's high density bipolar process, MOSAIC™ (Motorola Oxide Self Aligned Implanted Circuits).

- Complete Single Chip System for MPU Control (I<sup>2</sup>C Bus). Data and Clock Inputs are 3-Wire Bus Compatible
- Divide-by-8 Prescaler Accepts Frequencies up to 1.3 GHz

- 15 Bit Programmable Divider Accepts Input Frequencies up to 165 MHz
- Reference Divider: Programmable for Division Ratios 512 and 1024.
- 3-State Phase/Frequency Comparator
- Operational Amplifier for Direct Tuning Voltage Output (30 V)
- Four Integrated PNP Band Buffers for 40 mA ( $V_{CC1}$  to 14.4 V)
- Output Options for the Reference Frequency and the Programmable Divider
- High Sensitivity Preamplifier
- Circuit to Detect Phase Lock
- Fully ESD Protected



## PLL Tuning Circuits with I<sup>2</sup>C Bus

### MC44824/25D

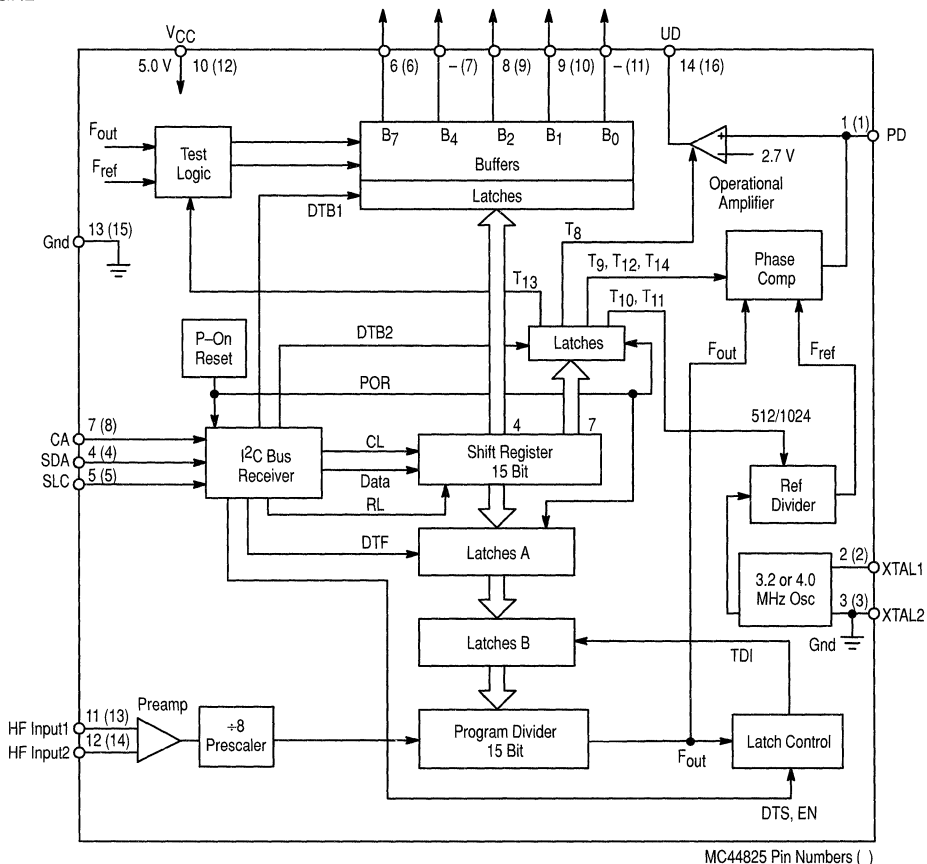
Case 751A, 751B

The MC44824/25 are tuning circuits for TV and VCR tuner applications. They contain on one chip all the functions required for PLL control of a VCO. The integrated circuits also contain a high frequency prescaler and thus can handle frequencies up to 1.3 GHz.

The MC44824/25 are manufactured on a single silicon chip using Motorola's high density bipolar process, MOSAIC™ (Motorola Oxide Self Aligned Implanted Circuits).

- Complete Single Chip System for MPU Control (I<sup>2</sup>C Bus). Data and Clock Inputs are 3-Wire Bus Compatible
- Divide-by-8 Prescaler Accepts Frequencies up to 1.3 GHz

- 15 Bit Programmable Divider
- Reference Divider: Programmable for Division Ratios 512 and 1024
- 3-State Phase/Frequency Comparator
- 4 Programmable Chip Addresses
- 3 Output Buffers (MC44824) respectively; 5 Output Buffers (MC44825) for 10 mA/15 V
- Operational Amplifier for use with External NPN Transistor
- SO-14 Package for MC44824 and SO-16 for MC44825
- High Sensitivity Preamplifier
- Fully ESD Protected





## PLL Tuning Circuit with 3–Wire Bus

### MC44827DTB

Case 948F

The MC44827 is a tuning circuit for TV and VCR tuner applications. This device contains on one chip all the functions required for PLL control of a VCO. This integrated circuit also contains a high frequency prescaler and thus can handle frequencies up to 1.3 GHz.

The MC44827 is controlled by a 3–wire bus. It has the same function as the MC44828 which is I<sup>2</sup>C bus controlled. The MC44827 and MC44828 can replace each other to allow conversion between 3–wire bus and I<sup>2</sup>C bus control.

The MC44827 is manufactured on a single silicon chip using Motorola's high density bipolar process, MOSAIC™ (Motorola Oxide Self Aligned Implanted Circuits).

The MC44827 has the same features as MC44817 with the following differences:

- Lower Power Consumption, 200 mW Typical
- Improved Prescaler with Higher Margins for Sensitivity and Temperature Range. (A typical device is functional in a temperature range greater than –40 to 100°C.)
- Lock Detector with Push–Pull Output
- No Bypass of Divide–by–8 Prescaler
- TSSOP Package

## PLL Tuning Circuit with I<sup>2</sup>C Bus

### MC44828DTB

Case 948F

The MC44828 is a tuning circuit for TV and VCR tuner applications. This device contains on one chip all the functions required for PLL control of a VCO. This integrated circuit also contains a high frequency prescaler and thus can handle frequencies up to 1.3 GHz.

The MC44828 is controlled by an I<sup>2</sup>C bus. It has the same function as the MC44827 which is 3–wire bus controlled. The MC44827 and MC44828 can replace each other to allow conversion between 3–wire bus and I<sup>2</sup>C bus control.

The MC44828 is manufactured on a single silicon chip using Motorola's high density bipolar process, MOSAIC™ (Motorola Oxide Self Aligned Implanted Circuits).

The MC44828 has the same features as MC44818 with the following differences:

- Lower Power Consumption, 200 mW Typical
- Improved Prescaler with Higher Margins for Sensitivity and Temperature Range. (A typical device is functional in a temperature range greater than –40 to 100°C.)
- Lock Detector with Push–Pull Output
- TSSOP Package

## PLL Tuning Circuit with I<sup>2</sup>C Bus

### MC44829D

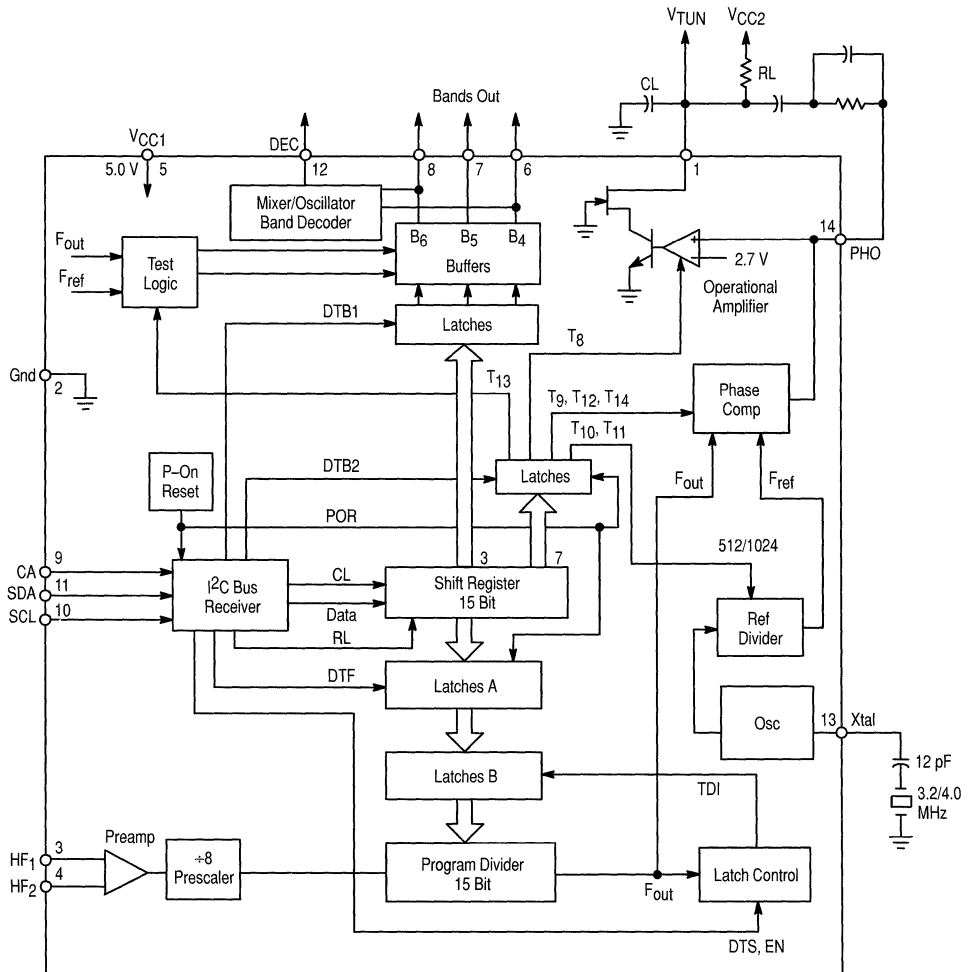
#### Case 751A

The MC44829 is a tuning circuit for TV and VCR tuner applications. It contains, on one chip, all the functions required for PLL control of a VCO. This integrated circuit also contains a high frequency prescaler and thus can handle frequencies up to 1.3 GHz. The circuit has a band decoder that provides the band switching signal for the mixer/oscillator circuit. The decoder is controlled by the buffer bits.

The MC44829 has programmable 512/1024 reference dividers and is manufactured on a single silicon chip using Motorola's high density bipolar process, MOSAIC™ (Motorola Oxide Self Aligned Implanted Circuits).

- Complete Single Chip System for MPU Control (I<sup>2</sup>C Bus)
- Divide-by-8 Prescaler Accepts Frequencies up to 1.3 GHz

- 15 Bit Programmable Divider
- Reference Divider: Programmable for Division Ratios 512 and 1024
- 3-State Phase/Frequency Comparator
- Operational Amplifier for Direct Tuning Voltage Output (30 V)
- Four Programmable Chip Addresses
- Integrated Band Decoder for the Mixer/Oscillator Circuit
- Band Buffers with Low "On" Voltage (0.4 V Maximum at 5.0 mA)
- Fully ESD Protected to MIL-STD-883C, Method 3015.7 (2000 V, 1.5 k $\Omega$ , 150 pF)



## Video Circuits (continued)

# Advanced PAL/NTSC Encoder

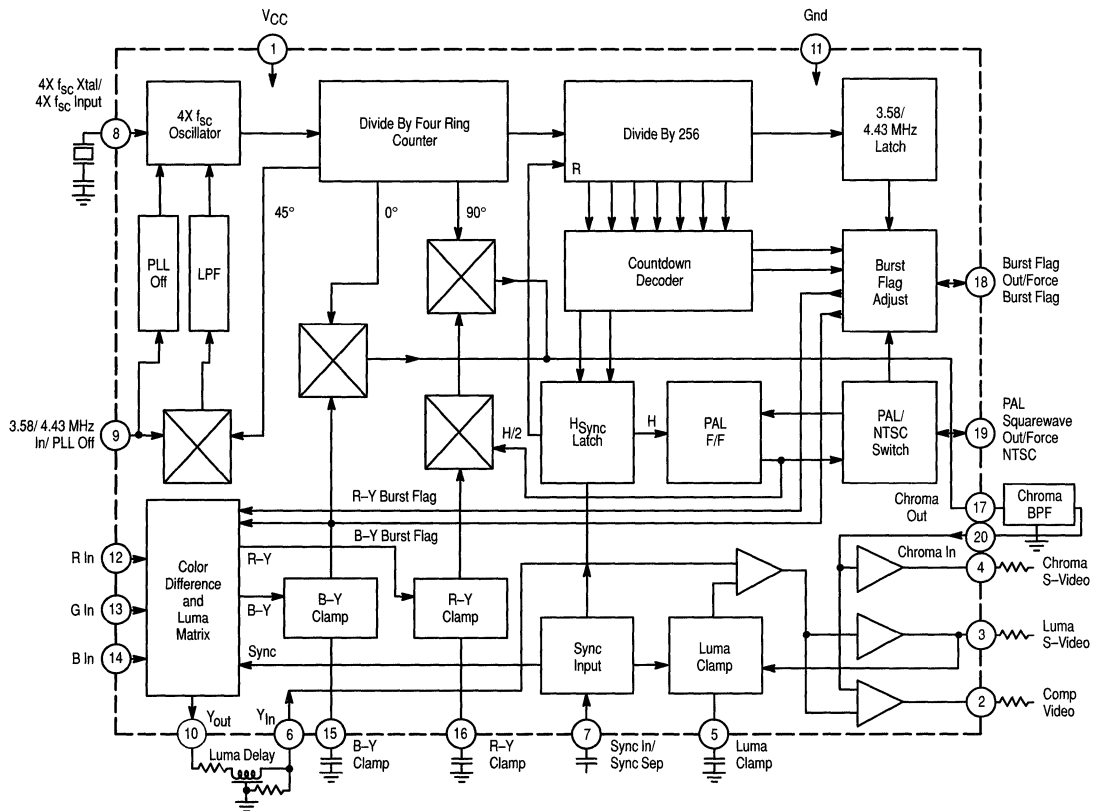
MC13077P, DW

Case 738, 751D

The MC13077 is an economical, high quality, RGB encoder for PAL or NTSC applications. It accepts red, green, blue and composite sync inputs and delivers either composite PAL or NTSC video, and S-Video Chroma and Luma outputs. The MC13077 is manufactured using Motorola's high density, bipolar MOSAIC® process.

- Single 5.0 V Supply
- Composite Output

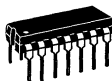
- S-Video Outputs
- PAL/NTSC Switchable
- PAL Squarewave Output
- PAL Sequence Resettable
- Internal/External Burst Flag
- Modulator Angles Accurate to 90°
- Burst Position/Duration Determined Digitally
- Subcarrier Reference from a Crystal or External Source



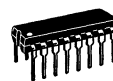
# Consumer Electronic Circuits Package Overview



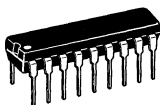
CASE 626  
P SUFFIX



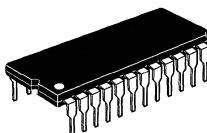
CASE 646  
P SUFFIX



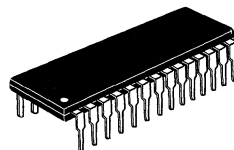
CASE 648  
P SUFFIX



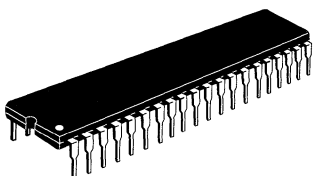
CASE 707  
P SUFFIX



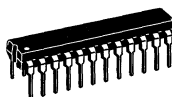
CASE 709  
P SUFFIX



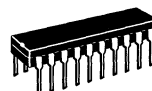
CASE 710  
P SUFFIX



CASE 711  
P SUFFIX



CASE 724  
P SUFFIX



CASE 738  
H, P SUFFIX



CASE 751  
D SUFFIX



CASE 751A  
D SUFFIX



CASE 751B  
D SUFFIX



CASE 751D  
DW SUFFIX



CASE 751E  
DW SUFFIX

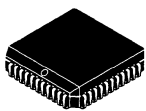


CASE 751F  
DW SUFFIX



CASE 751G  
DW SUFFIX

## Consumer Electronic Circuits Package Overview (continued)



**CASE 777**  
**FN SUFFIX**



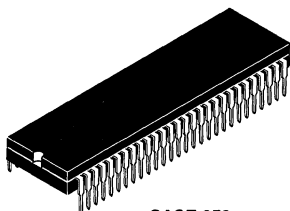
**CASE 824, 824A**  
**FB, FU SUFFIX**



**CASE 824D**  
**FTB SUFFIX**



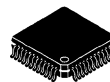
**CASE 824E**  
**FB SUFFIX**



**CASE 859**  
**B SUFFIX**



**CASE 873**  
**FU SUFFIX**



**CASE 898**  
**FB, FU, P SUFFIX**



**CASE 904**  
**F SUFFIX**



**CASE 948E**  
**DTB SUFFIX**



**CASE 948F**  
**DTB SUFFIX**



**CASE 948J**  
**DTB SUFFIX**



**CASE 967**  
**M SUFFIX**



# Automotive Electronic Circuits

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## In Brief . . .

Motorola Analog has established itself as a global leader in custom integrated circuits for the automotive market. With multiple design centers located on four continents, global process and assembly sites, and strategically located supply centers, Motorola serves the global automotive market needs. These products are key elements in the rapidly growing engine control, body, navigation, entertainment, and communication electronics portions of modern automobiles. Though Motorola is most active in supplying automotive custom designs, many of yesterday's proprietary custom devices have become standard products of today, available to the broad base manufacturers who support this industry. Today, based on new technologies, Motorola offers a wide array of standard products ranging from rugged high current "smart" fuel injector drivers which control and protect the fuel management system through the rigors of the underhood environment, to the latest SMARTMOS™ switches and series transient protectors. Several devices are targeted to support microprocessor housekeeping and data line protection. A wide range of packaging is available including die, flip-chip, and SOICs for high density layouts, to low thermal resistance multi-pin, single-in-line types for high power control ICs.

	<b>Page</b>
Voltage Regulators .....	4.9-2
Electronic Ignition .....	4.9-2
Special Functions .....	4.9-3
Package Overview .....	4.9-13

# Automotive Electronic Circuits

**Table 1. Voltage Regulators**

Function	Features	Suffix/ Package	Device
Low Dropout Voltage Regulator	Positive fixed and adjustable output voltage regulators which maintain regulation with very low input to output voltage differential.	Z/29, T/221A, T/314D, TH/314A, TV/314B, DT/369A, DT-1/369, D2T/936, D2T/936A, D/751	LM2931, C
Low Dropout Dual Regulator	Positive low voltage differential regulator which features dual 5.0 V outputs, with currents in excess of 750 mA (switched) and 10 mA standby, and quiescent current less than 3.0 mA.	T/314D, TH/314A, TV/314B, D2T/936A	LM2935
Automotive Voltage Regulator	Provides load response control, duty cycle limiting, under/overvoltage and phase detection, high side MOSFET field control, voltage regulation in 12 V alternator systems.	DW/751D	MC33092
Low Dropout Voltage Regulator	Positive 5.0 V, 500 mA regulator having on-chip power-up-reset circuit with programmable delay, current limit, and thermal shutdown.	T/314D, TV/314B	MC33267
Low Dropout Voltage Regulator	Positive 3.3 V, 5.0 V, 12 V, 800 mA regulator.	D/751, DT/369A	MC33269

**Table 2. Electronic Ignition**

Function	Features	Suffix/ Package	Device
Electronic Ignition Circuit	Used in high energy variable dwell electronic ignition systems with variable reluctance sensors. Dwell and spark energy are externally adjustable. "Bumped" die for inverted mounting to substrate.	P/626, D/751, Flip-Chip	MC33334, MCCF33334
Electronic Ignition Circuit	Used in high energy electronic ignition systems requiring differential Hall Sensor control. "Bumped" die for inverted mounting to substrate.	DW/751G, Flip-Chip	MC33093, MCCF33093
Electronic Ignition Circuit	Used in high energy electronic ignition systems requiring single Hall Sensor control. "Bumped" die for inverted mounting to substrate.	DW/751G, Flip-Chip	MC33094, MCCF33094
Electronic Ignition Circuit	Used in high energy electronic ignition systems requiring single Hall Sensor control. Dwell feedback for coil variation. "Bumped" die for inverted mounting to substrate.	DW/751G, Flip-Chip	MC79076, MCCF79076



**Table 3. Special Functions**

Function	Features	Suffix/ Package	Device
Low Side Protected Switch	Single automotive low side switch having CMOS compatible input, 1.0 A maximum rating, with overcurrent, overvoltage and thermal protection.	T/221A, T-1/314D, DW/751G	MC3392
Low Current High-Side Switch	Drives loads from positive side of power supply and protects against high-voltage transients.	T/314D, DW/751G	MC3399
High-Side TMOS Driver	Designed to drive and protect N-channel power MOSFETs used in high side switching applications. Has internal charge pump, externally programmed timer and fault reporting.	P/626, D/751	MC33091A
MI-Bus Interface Stepper Motor Controller	High noise immunity serial communication using MI-Bus protocol to control relay drivers and motors in harsh environments. Four phase signals drive two phase motors in either half or full-step modes.	DW/751G	MC33192
Quad Fuel Injector Driver	Four low side switches with parallel CMOS compatible input control, $\leq 7.0$ mA quiescent current, $0.25 \Omega r_{DS(on)}$ at 25°C independent outputs with 3.0 A current limiting and internal 65 V clamps.	T/821D, TV/821C	MC33293A
Octal Serial Output Switch	Eight low side switches having 8-bit serial CMOS compatible input control, serial fault reporting, $\leq 4.0$ mA quiescent current, independent $0.45 \Omega r_{DS(on)}$ at 25°C outputs with 3.0 A minimum current limiting and internal 55 V clamps.	P/738, DW/751E	MC33298
Integral Alternator Regulator	Control device used in conjunction with a Darlington device to monitor and control the field current in alternator charging systems. "Bumped" die for inverted mounting to substrate.	D/751A, Flip-Chip	MC33095 MCCF33095
Peripheral Clamping Array	Protects up to six MPU I/O lines against voltage transients.	*/626, D/751	TCF6000
Automotive Direction Indicator	Detects defective lamps and protects against overvoltage in automotive turn-signal applications. Replaces UAA1041B in most applications.	D/751, P/626	MC33193
Automotive Wash Wiper Timer	Standard wiper timer control device that drives a wiper motor relay and can perform the intermittent, afterwash and continuous wiper timer functions.	D/751, P/626	MC33197A
Automotive ISO 9141 Serial Link Driver	Interface between the two-wire asynchronous serial communication interface (SCI) of a microcontroller and a special one-wire care diagnosis system (DIA).	D/751A	MC33199

\* No Suffix

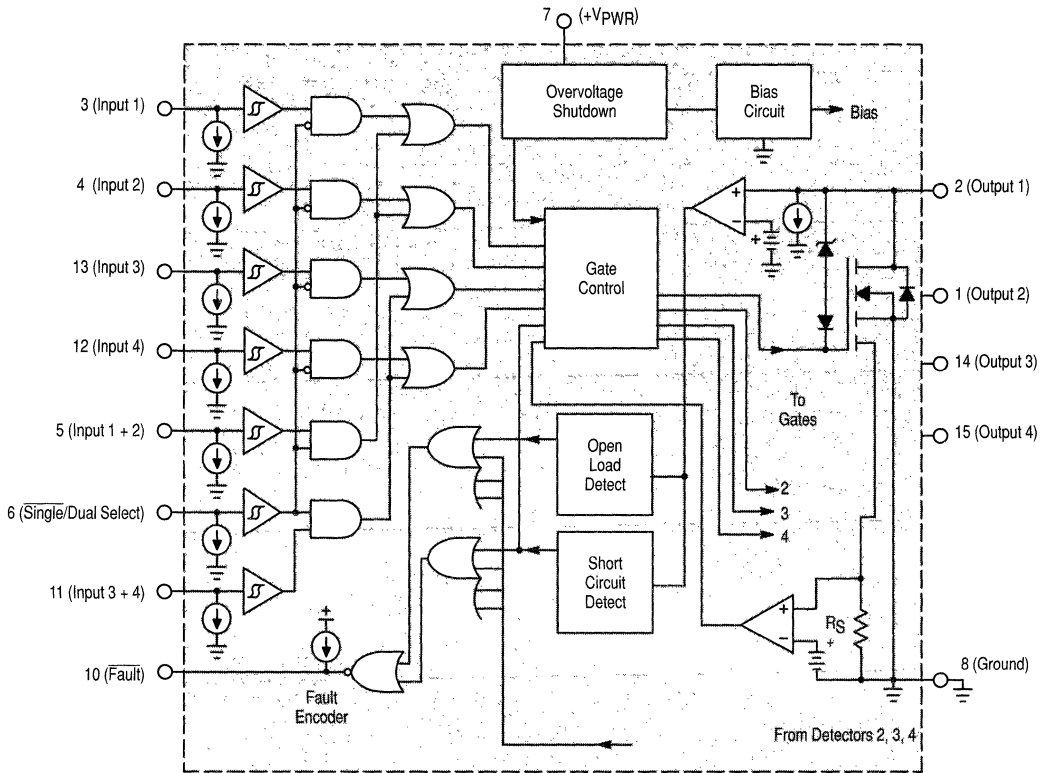
# Quad Fuel Injector Driver

MC33293AT, MC33293ATV

$T_J = -40^\circ$  to  $+150^\circ\text{C}$ , Case 821D, C

The MC33293AT is a monolithic quad low-side switching device having CMOS logic, bipolar/CMOS analog circuitry, and DMOS power FETs. All inputs are CMOS compatible. Each independent output is internally clamped to 65 V, current limited to  $\geq 3.0$  A, and has an  $r_{DS(on)}$  of  $\leq 0.25 \Omega$  with  $V_{PWR} \geq 9.0$  V and may be paralleled to lower  $r_{DS(on)}$ .  $\overline{\text{Fault}}$  output reports existence of open loads (outputs "On" or "Off"),

shorted loads, and over temperature condition of outputs. A shorted load condition will shut off only the specific output involved while allowing other outputs to operate normally. An overvoltage condition will shut off all outputs for the overvoltage duration. A single/dual mode select pin allows either independent input/output operation or paired output operation.



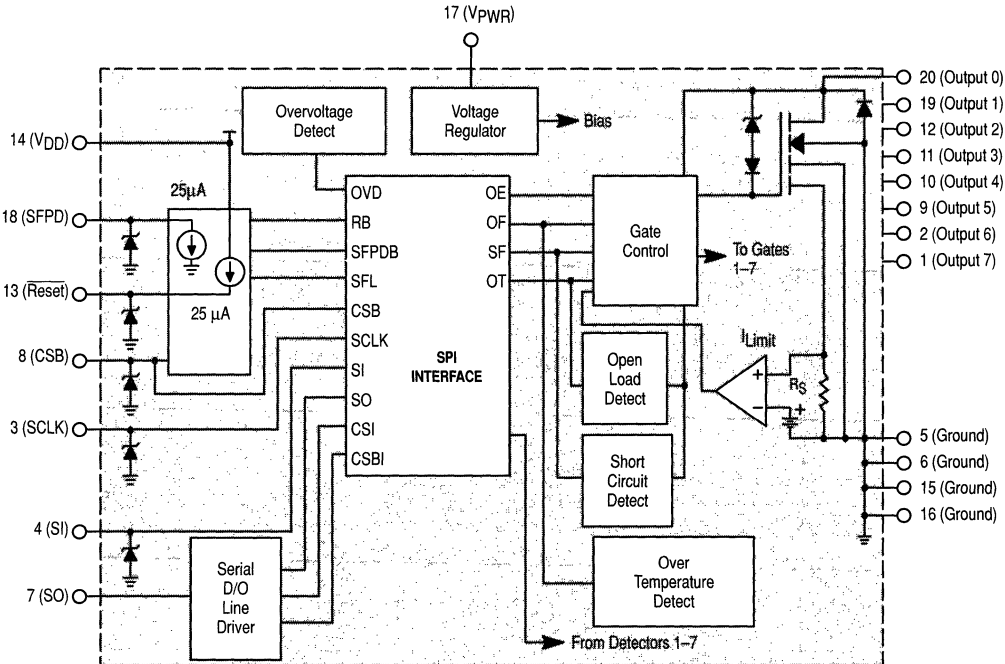
# Octal Serial Switch

MC33298P, MC33298DW

$T_J = -40^\circ$  to  $+150^\circ\text{C}$ , Case 738, 751E

The MC33298 is a monolithic eight output low-side switch with 8-bit serial input control. Incorporates CMOS logic, bipolar/CMOS analog circuitry, and DMOS power FETs. All inputs are CMOS compatible. It is designed to interface to a microcontroller and switch inductive or incandescent loads.

Each independent output is internally clamped to 55 V, current limited to  $\geq 3.0$  A, and has an  $r_{DS(on)}$  of  $\leq 0.45 \Omega$  with  $V_{PWR} \geq 9.0$  V. This device has low standby current, cascadable fault status reporting, output diagnostics, and shutdown for each output.



# Dual High-Side Switch

## MC33143DW

$T_A = -40^\circ$  to  $+125^\circ\text{C}$ , Case 751E

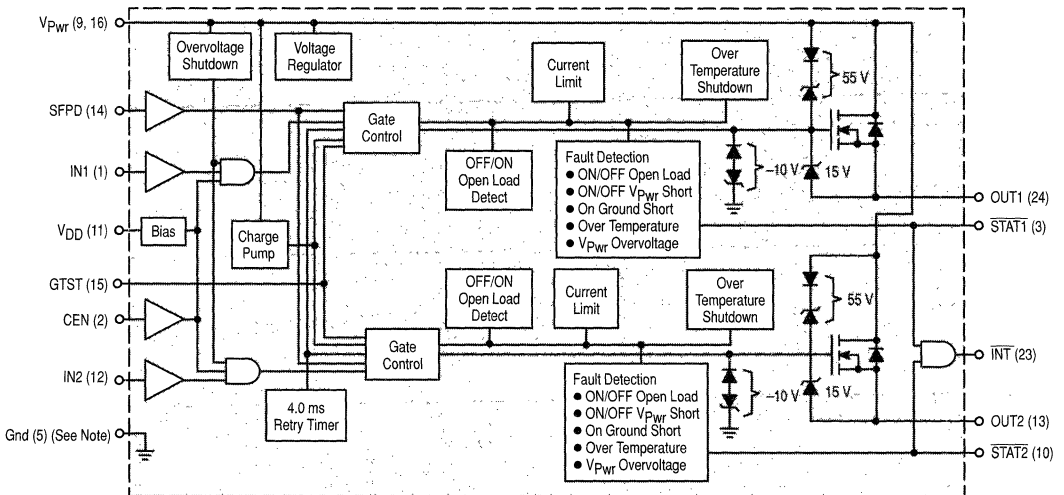
The MC33143 is a dual high-side switch designed for solenoid control in harsh automotive applications, but is well suited for other environments. The device can also be used to control small motors and relays as well as solenoids. The MC33143 incorporates SMARTMOS™ technology, with CMOS logic, bipolar/MOS analog circuitry, and DMOS power outputs. An internal charge pump is incorporated for efficient gate enhancement of the internal high-side power output devices. The outputs are designed to provide current to low impedance solenoids. The MC33143 provides individual output fault status reporting along with internal Overcurrent and Over Temperature protection. The device also has Overvoltage protection, with automatic recovery, which "globally" disables both outputs for the duration of an Overvoltage condition. Each output has individual Overcurrent and Over Temperature shutdown with automatic retry recovery. Outputs are enabled with a CMOS logic high signal applied to an input to providing true logic control. The outputs, when turned on, provide full supply (battery) voltage across the solenoid coil.

The MC33143 is packaged in an economical 24 pin surface mount power package and specified over an operating voltage of  $5.5\text{ V} \leq V_{PWR} < 26\text{ V}$  for  $-40^\circ\text{C} \leq T_A \leq 125^\circ\text{C}$ .

- Designed to Operate Over Wide Supply Voltages of 5.5 V to 26 V

- Dual High-Side Outputs Clamped to  $-10\text{ V}$  for Driving Inductive Loads
- Internal Charge Pump for Enhanced Gate Drive
- Interfaces Directly to a Microcontroller with Parallel Input Control
- Outputs Current Limited to 3.0 A to 6.0 A for Driving Incandescent Loads
- Chip Enable "Sleep Mode" for Power Conservation
- Individual Output Status Reporting
- Fault Interrupt Output for System Interrupt Use
- Output ON or OFF Open Load Detection
- Overvoltage Detection and Shutdown
- Output Over Temperature Detection and Shutdown with Automatic Retry
- Sustained Current Limit or Immediate Overcurrent Shutdown Output Modes
- Output Short to Ground Detection and Shutdown with Automatic Retry
- Output Short to  $V_{PWR}$  Detection

Simplified Internal Block Diagram



**NOTE:** Pins 5, 6, 7, 8, 17, 18, 19 and 20 should all be grounded so as to provide electrical as well as thermal heatsinking of the device.

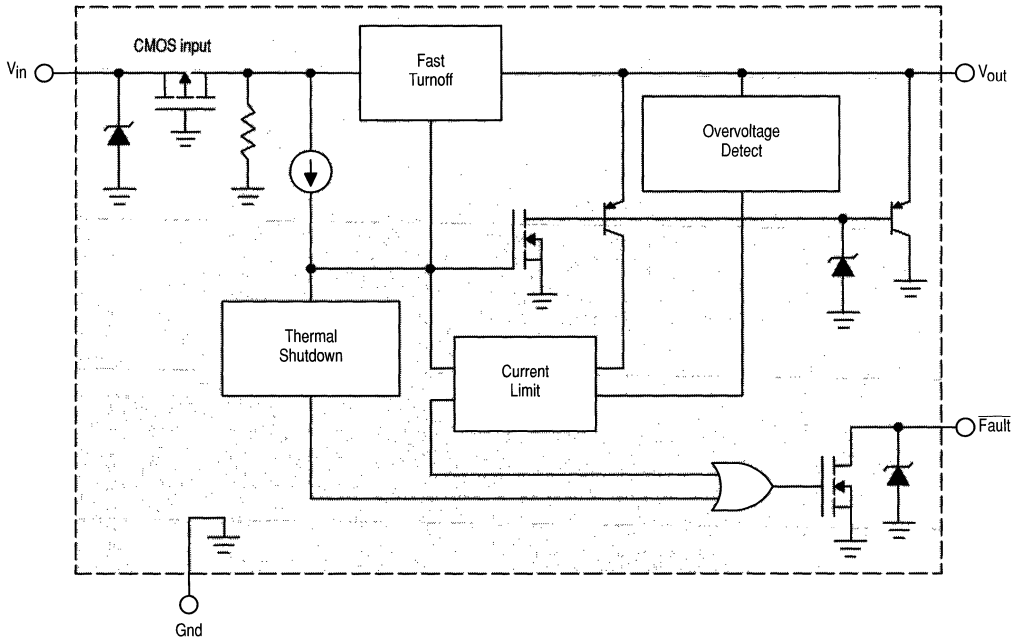
# Low Side Protected Switch

MC3392T, T-1, DW

$T_J = -40^\circ$  to  $+150^\circ\text{C}$ ,  
Case 221A, 314D, 751G

Single low side protected switch with fault reporting capability. Input is CMOS compatible. Output is short circuit protected to 1.0 A minimum with a unique current fold-back feature. Device has internal output clamp for driving inductive loads with overcurrent, overvoltage, and thermal protection. When driving a moderate load, the MC3392 performs as an

extremely high gain, low saturation Darlington transistor having a CMOS input characteristic with added protection features. In some applications, the three terminal version can replace industry standard TIP100/101 NPN power Darlington transistors.



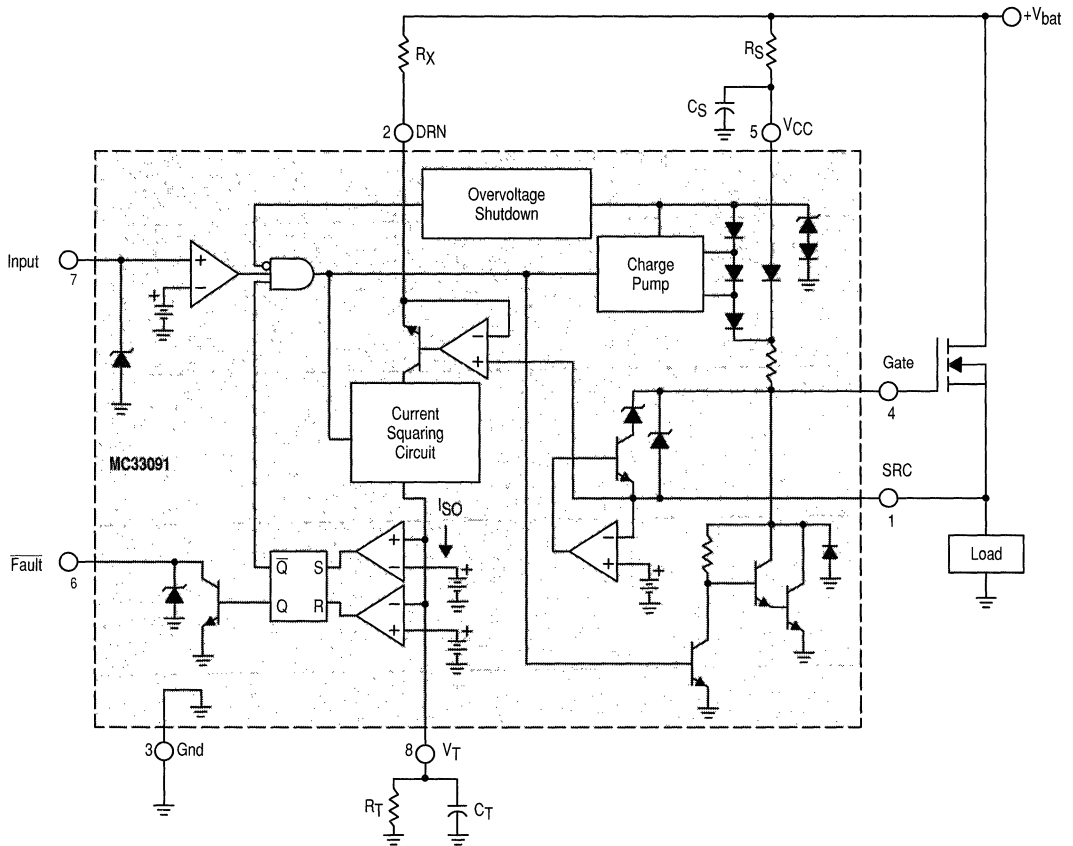
# High Side TMOS Driver

## MC33091AP, AD

$T_J = -40^\circ$  to  $+150^\circ\text{C}$ , Case 626, 751

Offers an economical solution to drive and protect N-channel power TMOS devices used in high side switching configurations. Unique device monitors load resulting  $V_{DS}$ . TMOS voltage to produce a proportional current used to drive an externally programmed over current timer circuit to protect the TMOS device from shorted load conditions. Timer can be programmed to accommodate driving incandescent loads.

Few external components required to drive a wide variety of N-channel TMOS devices. A Fault output is made available through the use of an open collector NPN transistor requiring a single pull-up resistor for operation. Input is CMOS compatible. Device uses  $\leq 3.0 \mu\text{A}$  standby current and has an internal charge pump requiring no external components for operation.

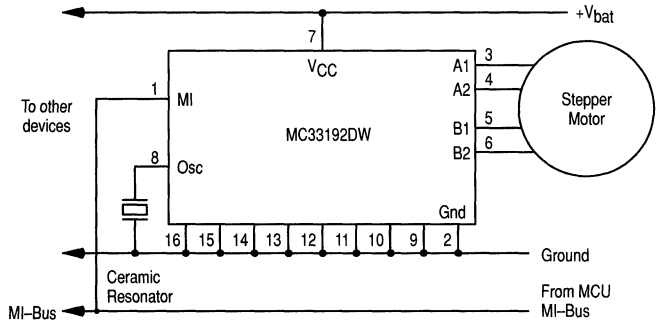


# MI-Bus Interface Stepper Motor Controller

## MC33192DW

$T_J = -40^\circ$  to  $+100^\circ\text{C}$ , Case 751G

Intended to control loads in harsh automotive environments using a serial communication bus. Can provide satisfactory real time control of up to eight stepper motors using MI-Bus protocol. Use of MI-Bus offers a noise immune system solution for difficult applications involving relays and motors. The stepper motor controller provides four phase signals to drive two phase motors in either half of full-step modes. Designed to interface to a microprocessor with minimal amount of wiring, affording an economical and versatile system.



# Automotive Direction Indicator

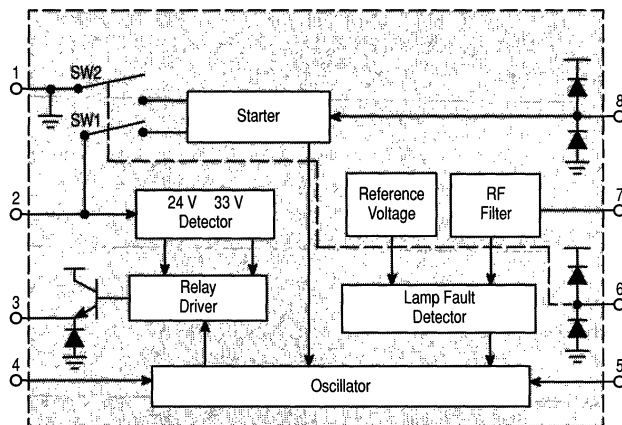
## MC33193P, D

$T_A = -40^\circ$  to  $+125^\circ\text{C}$ , Case 626, 751

The MC33193 is a new generation industry standard UAA1041 "Flasher". It has been developed for enhanced EMI sensitivity, system reliability, and improved wiring simplification. The MC33193 is pin compatible with the UAA1041 and UAA1041B in the standard application configuration as shown in Figure 9, without lamp short circuit detection and using a 20 mΩ shunt resistor. The MC33193 has a standby mode of operation requiring very low standby supply current and can be directly connected to the vehicle's battery. It includes a RF filter on the Fault detection pin (Pin 7)

for EMI purposes. Fault detection thresholds are reduced relative to those of the UAA1041 allowing a lower shunt resistance value (20 mΩ) to be use.

- Pin Compatible with the UAA1041
- Defective Lamp Detection Threshold
- RF Filter for EMI Purposes
- Load Dump Protection
- Double Battery Capability for Jump Start Protection
- Internal Free Wheeling Diode Protection
- Low Standby Current Mode



# Automotive Wash Wiper Timer

## MC33197AD

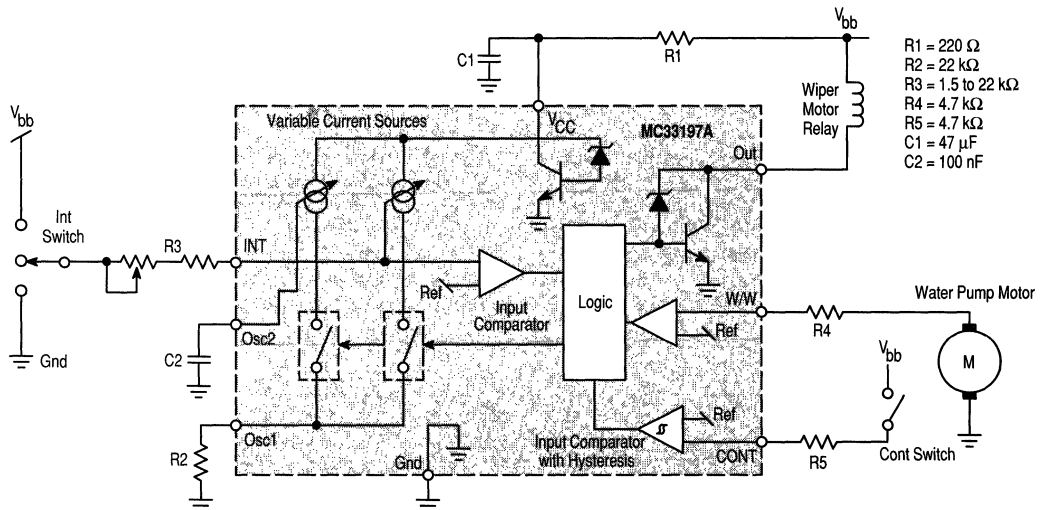
$T_A = -40^\circ$  to  $+105^\circ\text{C}$ , Case 751

## MC33197AP

$T_A = -40^\circ$  to  $+125^\circ\text{C}$ , Case 626

The MC33197A is a standard wiper timer control device designed for harsh automotive applications. The device can perform the intermittent, after wash, and continuous wiper timer functions. It is designed to directly drive a wiper motor relay. The MC33197A requires very few external components for full system implementation. The intermittent control pin can be switched to ground or  $V_{bat}$  to meet a large variety of possible applications. The intermittent timing can be fixed or adjustable via an external resistor. The MC33197A is built using bipolar technology and parametrically specified over the automotive ambient temperature range and 8.0 to 16 V supply voltage. The MC33197A can operate in both front and rear wiper applications.

- Adjustable Time Interval of Less Than 500 ms to More Than 30 s
- Intermittent Control Pin Can Be Switched to Ground or  $V_{bat}$
- Adjustable After Wipe Time
- Priority to Continuous Wipe
- Minimum Number of Timing Components
- Integrated Relay Driver With Free Wheeling Protection Diode
- Operating Voltage Range From 8.0 to 16 V
- For Front Wiper and Rear Wiper Window Applications





# Automotive ISO 9141 Serial Link Driver

## MC33199D

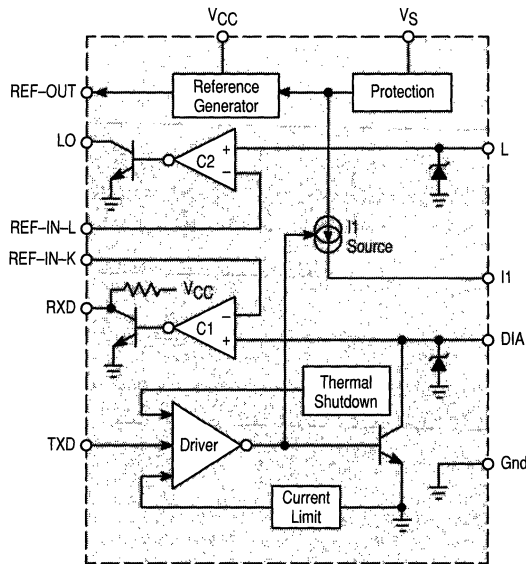
$T_A = -40^\circ$  to  $+125^\circ\text{C}$ , Case 751A

The MC33199D is a serial interface circuit used in diagnostic applications. It is the interface between the microcontroller and the special K and L Lines of the ISO diagnostic port. The MC33199D has been designed to meet the "Diagnosis System ISO 9141" specification.

The device has a bi-directional bus K Line driver, fully protected against short circuits and over temperature. It also includes the L Line receiver, used during the wake up sequence in the ISO transmission.

The MC33199 has a unique feature which allows transmission baud rate up to 200 k baud.

- Electrically Compatible with Specification "Diagnosis System ISO 9141"
- Transmission Speed Up to 200 k Baud
- Internal Voltage Reference Generator for Line Comparator Thresholds
- TXD, RXD and LO Pins are 5.0 V CMOS Compatible
- High Current Capability of DIA Pin (K Line)
- Short Circuit Protection for the K Line Input
- Over Temperature Shutdown with Hysteresis
- Large Operating Range of Driver Supply Voltage
- Full Operating Temperature Range
- ESD Protected Pins



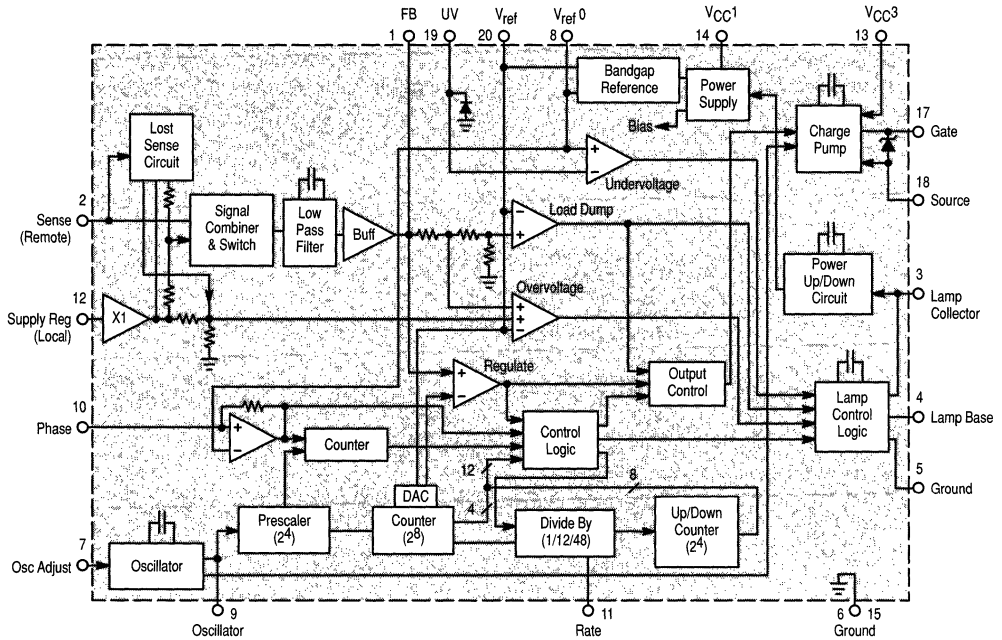
# Alternator Voltage Regulator

MC33092DW

$T_J = -40^\circ$  to  $+125^\circ\text{C}$ , Case 751D

Provides voltage regulation and load response control in diode rectified 12 V alternator charging systems. Provides externally programmed load response control of the alternator output current to eliminate engine speed hunting and vibration due to sudden electrical loads. Monitors and compares the

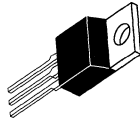
system battery voltage to an externally programmed set point value and pulse width modulates an N-channel MOSFET transistor to control the average alternator field current. In addition, has duty cycle limiting, under/overvoltage and phase detection (broken belt) protective features.



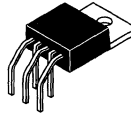
# Automotive Electronic Circuits Package Overview



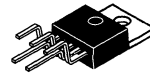
CASE 29  
Z SUFFIX



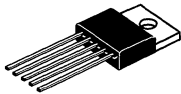
CASE 221A  
T SUFFIX



CASE 314A  
TH SUFFIX



CASE 314B  
TV SUFFIX



CASE 314D  
T, T-1 SUFFIX



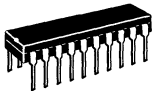
CASE 369  
DT-1 SUFFIX



CASE 369A  
DT SUFFIX



CASE 626  
P, NO SUFFIX



CASE 738  
P SUFFIX



CASE 751  
D SUFFIX



CASE 751A  
D SUFFIX



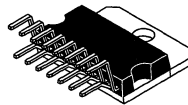
CASE 751D  
DW SUFFIX



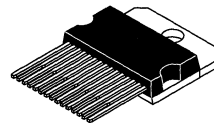
CASE 751E  
DW SUFFIX



CASE 751G  
DW SUFFIX



CASE 821C  
TV SUFFIX



CASE 821D  
T SUFFIX



CASE 936  
D2T SUFFIX



CASE 936A  
D2T SUFFIX



# Other Analog Circuits

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## In Brief . . .

Other analog circuits are provided for special applications with both bipolar and CMOS technologies. These circuits range from the industry standard analog timing circuits and multipliers to specialized CMOS smoke detectors. These products provide key functions in a wide range of applications, including data transmission, commercial smoke detectors, and various industrial controls.

	<b>Page</b>
Timing Circuits . . . . .	4.10-2
Singles . . . . .	4.10-2
Duals . . . . .	4.10-2
Multipliers . . . . .	4.10-2
Linear Four-Quadrant Multipliers . . . . .	4.10-2
Smoke Detectors (CMOS) . . . . .	4.10-3
Package Overview . . . . .	4.10-4

# Timing Circuits

These highly stable timers are capable of producing accurate time delays or oscillation. In the time delay mode of operation, the time is precisely controlled by one external resistor and capacitor. For a stable operation as an oscillator, the free-running frequency and the duty cycle are both accurately controlled with two external resistors and one capacitor. The output structure can source or sink up to 200 mA or drive TTL circuits. Timing intervals from microseconds through hours can be obtained. Additional terminals are provided for triggering or resetting if desired.

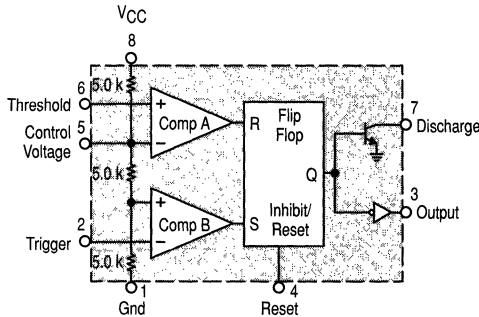
## Singles

### MC1455P1, D

$T_A = 0^\circ$  to  $+70^\circ\text{C}$ , Case 626, 751

### MC1455BP1, D

$T_A = -40^\circ$  to  $+85^\circ\text{C}$ , Case 626, 751



## Duals

### MC3456P

$T_A = 0^\circ$  to  $+70^\circ\text{C}$ , Case 646

### NE556N, D

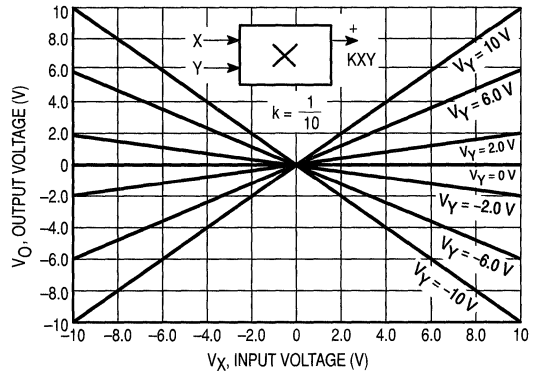
$T_A = 0^\circ$  to  $+70^\circ\text{C}$ , Case 646, 751A

# Multipliers

## Linear Four-Quadrant Multipliers

Multipliers are designed for use where the output voltage is a linear product of two input voltages. Typical applications include: multiply, divide, square, root-mean-square, phase detector, frequency doubler, balanced modulator/demodulator, electronic gain control.

Multiplier Transfer Characteristics



### MC1494P

$T_A = 0^\circ$  to  $+70^\circ\text{C}$ , Case 648

This device has all the necessary internal regulation and references. The single-ended output is referenced to ground.

### MC1495D, P

$T_A = 0^\circ$  to  $+70^\circ\text{C}$ , Case 751A, 646

Maximum versatility is assured by allowing the user to select the level shift method.

### MC1495BP

$T_A = -40^\circ$  to  $+125^\circ\text{C}$ , Case 646

Linearity and offset are actually tested over temperature. This is an improved specification over previous versions.

# Smoke Detectors (CMOS)

These smoke detector ICs require a minimum number of external components. When smoke is sensed, or a low battery voltage is detected, an alarm is sounded via an external

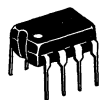
piezoelectric transducer. All devices are designed to comply with UL specifications.

**Table 1. Smoke Detectors (CMOS)**

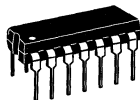
Function	Recommended Power Source	Unique Feature	Low Battery Detector	Piezoelectric Horn Driver	Complies with UL217 and UL268	Device Number	Suffix/Package
Ionization-Type Smoke Detector	Battery	High Input Impedance FET Comparator	✓	✓	✓	MC14467-1	P1/646
	Line		-	-	✓	MC14578	P/648
Ionization-Type Smoke Detector with Interconnect	Battery		✓	✓	✓	MC14468	
	Line		-	✓	✓	MC14470	
Photoelectric-Type Smoke Detector with Interconnect	Battery	Photo Amplifier	✓	✓	✓	MC145010	P/648, DW/751G
	Line		(1)	✓	✓	MC145011	
	Battery	Photo Amplifier, Temporal Pattern	✓	✓	✓	MC145012	P/646, DW/751G
	Line		(1)	✓	✓	MC145013	
Ionization-Type Smoke Detector	Battery	High Input Impedance FET Comparator, Temporal Pattern	✓	✓	✓	MC145017	P/648
Ionization-Type Smoke Detector with Interconnect	Battery		✓	✓	✓	MC145018	

(1) Low-supply detector.

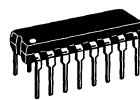
## Other Analog Circuits Package Overview



**CASE 626**  
**P1 SUFFIX**



**CASE 646**  
**N, P, P1 SUFFIX**



**CASE 648**  
**P SUFFIX**



**CASE 751**  
**D SUFFIX**



**CASE 751A**  
**D SUFFIX**



**CASE 751G**  
**DW SUFFIX**



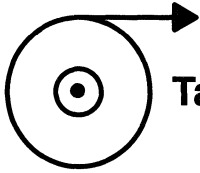
# Tape and Reel Options

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## In Brief . . .

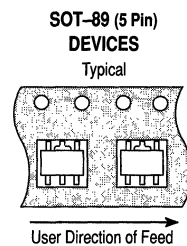
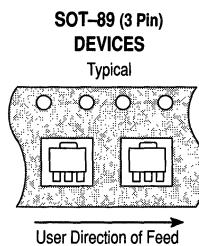
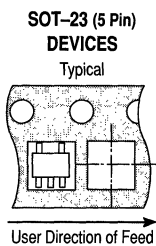
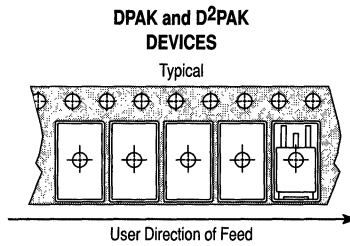
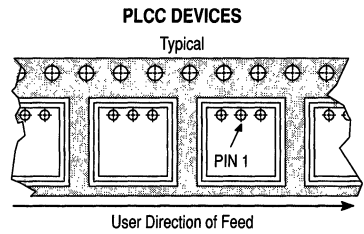
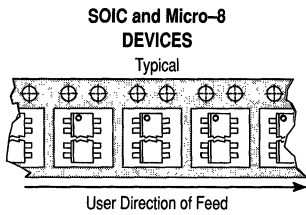
Motorola offers the convenience of Tape and Reel packaging for our growing family of standard integrated circuit products. Reels are available to support the requirements of both first and second generation pick-and-place equipment. The packaging fully conforms to the latest EIA-481A specification. The antistatic embossed tape provides a secure cavity, sealed with a peel-back cover tape.

	<b>Page</b>
Tape and Reel Configurations . . . . .	4.11-2
Tape and Reel Information Table . . . . .	4.11-4
Analog MPQ Table . . . . .	4.11-5



# Tape and Reel Configurations

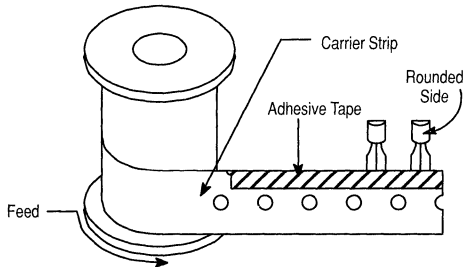
## Mechanical Polarization



# Tape and Reel Configurations (continued)

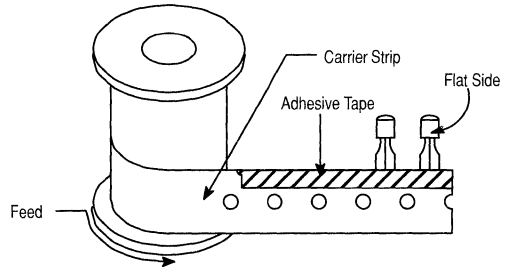
## TO-92 Reel Styles

**STYLE A  
(Preferred)**



Rounded side of transistor and adhesive tape visible.

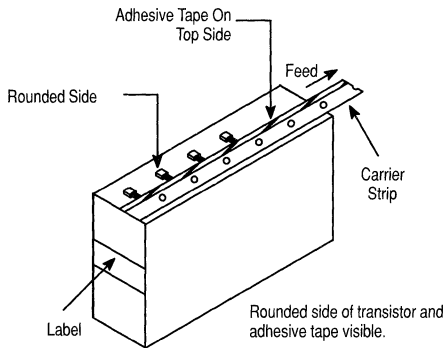
**STYLE E**



Flat side of transistor and adhesive tape visible.

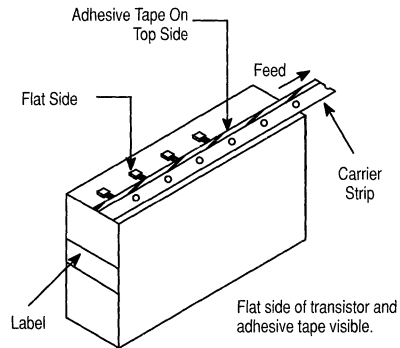
## TO-92 Ammo Pack Styles

**STYLE P  
(Preferred)**



Rounded side of transistor and adhesive tape visible.

**STYLE M**

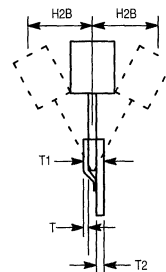
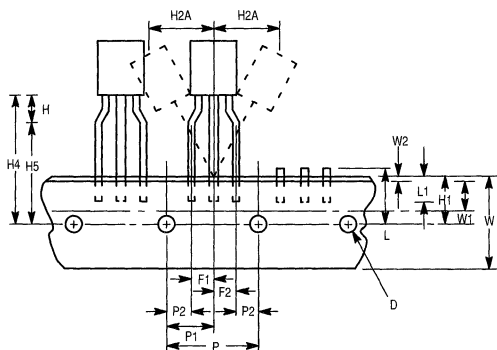


Flat side of transistor and adhesive tape visible.

Style P ammo pack is equivalent to Styles A and B of reel pack dependent on feed orientation from box.

Style M ammo pack is equivalent to Style E of reel pack dependent on feed orientation from box.

## TO-92 EIA Radial Tape in Fan Fold Box or On Reel



# Tape and Reel Information Table

Package	Tape Width (mm)	Devices <sup>(1)</sup> per Reel	Reel Size (inch)	Device Suffix
SO-8, SOP-8	12	2,500	13	R2
SO-14	16	2,500	13	R2
SO-16	16	2,500	13	R2
SO-16L, SO-8+8L WIDE	16	1,000	13	R2
SO-20L WIDE	24	1,000	13	R2
SO-24L WIDE	24	1,000	13	R2
SO-28L WIDE	24	1,000	13	R2
SO-28L WIDE	32	1,000	13	R3
Micro-8	12	2,500	13	R2
PLCC-20	16	1,000	13	R2
PLCC-28	24	500	13	R2
PLCC-44	32	500	13	R2
PLCC-52	32	500	13	R2
PLCC-68	44	250	13	R2
PLCC-84	44	250	13	R2
TO-226AA (TO-92) <sup>(2)</sup>	18	2,000	13	RA, RE, RP, or RM (Ammo Pack) only
DPAK	16	2,500	13	RK
D <sup>2</sup> PAK	24	800	13	R4
SOT-23 (5 Pin)	8	3,000	7	TR
SOT-89 (3/5 Pin)	12	1,000	7	T1

<sup>(1)</sup> Minimum order quantity is 1 reel. Distributors/OEM customers may break lots or reels at their option, however broken reels may not be returned.

<sup>(2)</sup> Integrated circuits in TO-226AA packages are available in Styles A and E only, with optional "Ammo Pack" (Suffix RP or RM). The RA and RP configurations are preferred. For ordering information please contact your local Motorola Semiconductor Sales Office.

# Analog MPQ Table

## Tape/Reel and Ammo Pack

Package Type	Package Code	MPQ
<b>PLCC</b>		
Case 775	0802	1000/reel
Case 776	0804	500/reel
Case 777	0801	500/reel
<b>SOIC</b>		
Case 751	0095	2500/reel
Case 751A	0096	2500/reel
Case 751B	0097	2500/reel
Case 751G	2003	1000/reel
Case 751D	2005	1000/reel
Case 751E	2008	1000/reel
Case 751F	2009	1000/reel
<b>Micro-8</b>		
Case 846A	-	2500/reel
<b>TO-92</b>		
Case 29	0031	2000/reel
Case 29	0031	2000/Ammo Pack
<b>DPAK</b>		
Case 369A	-	2500/reel
<b>D<sup>2</sup>PAK</b>		
Case 936	-	800/reel
<b>SOT-23 (5 Pin)</b>		
Case 1212	-	3000/reel
<b>SOT-89 (3 Pin)</b>		
Case 1213	-	1000/reel
<b>SOT-89 (5 Pin)</b>		
Case 1214	-	1000/reel



# Communications, Power and Signal Technologies Group Products

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## In Brief . . .

Many leading semiconductor manufacturers have either de-emphasized or eliminated discrete components from their product portfolio. At Motorola, exceptional long-term growth and outstanding customer acceptance of our portfolio are the most significant effects of Motorola's superiority in providing bipolar and MOS transistors, diodes, thyristors, zeners, opto, RF, rectifier, and sensor devices.

Consistent, ongoing improvements in product development and packaging processing continue to ensure Motorola's position as the most broad-based discrete supplier in the world. The increased use of automatic placement equipment has driven the trend towards surface mount packaging.

Motorola continues to expand upon a broad offering of surface mount packages which continue to advance state-of-the-art designs that cannot be accomplished with insertion technology. Surface mount technology is cost effective, allowing users the opportunity to utilize smaller units and increased functions with less board space. In many electronic applications, complex integrated solutions with a multitude of functions can replace several active and passive components.

SMARTDISCRETES, RF hybrid amplifiers and modules and RF monolithic integrated circuits, pressure and temperature sensors, optoelectronics and hybrid power modules are a few of the exciting new products which provide more reliable, intelligent discrete devices. Key initiatives to raise products and services to a Six Sigma standard (99.9997% defect-free), reduce total cycle time in all activities, and provide leadership in the areas of product and manufacturing ensure that Motorola will continue to be the manufacturer of choice for all your discrete semiconductor requirements.

	<b>Page</b>
Small Signal Transistors, FETs and Diodes . . . . .	5.1-1
TVS/Zeners	
Transient Voltage Suppressors	
Zener Regulator and Reference Diodes . . . . .	5.2-1
Hybrid Power Module Operation . . . . .	5.3-1
TMOS Power MOSFETs Products . . . . .	5.4-1
Bipolar Power Transistors . . . . .	5.5-1
Rectifiers . . . . .	5.6-1
Thyristors and Triggers . . . . .	5.7-1
Optoelectronic Devices . . . . .	5.8-1
Sensors . . . . .	5.9-1
RF Products . . . . .	5.10-1
Surface Mount Information . . . . .	5.11-1
Tape and Reel Specifications and Packaging Specifications . . . . .	5.12-1





# Small Signal Transistors, FETs and Diodes

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## In Brief . . .

New in this revision is Motorola's GreenLine™ portfolio of devices. They feature energy-conserving traits superior to those of our existing line of standard parts for the same usage. GreenLine devices can actually help reduce the power demands of your products.

Also new are the Small Signal Multi-integrated devices. These are intended to save board space by reduced part count and functionality. Four to six devices have been integrated into one small package.

Also, this section highlights semiconductors that are the most popular and have a history of high usage for the most applications.

It covers a wide range of Small Signal plastic and metal-can semiconductors.

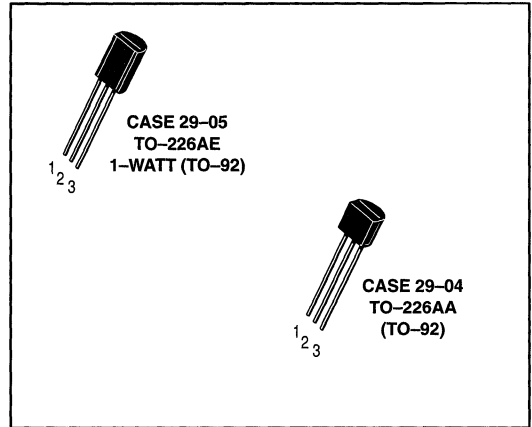
A large selection of encapsulated plastic transistors, FETs and diodes are available for surface mount and insertion assembly technology. Plastic packages include TO-92 (TO-226AA), 1 Watt TO-92 (TO-226AE), SOT-23, SC-59, SC-70/SOT-323 and SOT-223. Plastic multiples are available in 14-pin and 16-pin dual in-line packages for insertion applications: SO-8, SO-14, and SO-16 for surface mount applications.

	<b>Page</b>
Bipolar Transistors . . . . .	5.1-2
Plastic-Encapsulated Transistors . . . . .	5.1-2
Plastic-Encapsulated Multiple Transistors . . . . .	5.1-8
Plastic-Encapsulated Surface Mount Transistors . . . . .	5.1-10
Metal-Can Transistors . . . . .	5.1-18
Field-Effect Transistors . . . . .	5.1-20
JFETs . . . . .	5.1-20
MOSFETs . . . . .	5.1-22
Surface Mount FETs . . . . .	5.1-23
Tuning and Switching Diodes . . . . .	5.1-25
Tuning Diodes — Abrupt Junction . . . . .	5.1-25
Tuning Diodes — Hyper-Abrupt Junction . . . . .	5.1-29
Schottky Diodes . . . . .	5.1-33
Switching Diodes . . . . .	5.1-35
Multiple Switching Diodes . . . . .	5.1-39
GreenLine Devices . . . . .	5.1-41
Small Signal Multi-integrated Devices . . . . .	5.1-43

# Bipolar Transistors

## Plastic-Encapsulated Transistors

Motorola's Small Signal TO-226 plastic transistors encompass hundreds of devices with a wide variety of characteristics for general-purpose, amplifier and switching applications. The popular high-volume package combines proven reliability, performance, economy and convenience to provide the perfect solution for industrial and consumer design problems. All devices are laser marked for ease of identification and shipped in antistatic containers, as part of Motorola's ongoing practice of maintaining the highest standards of quality and reliability.



**Table 1. Plastic-Encapsulated General-Purpose Transistors**

These general-purpose transistors are designed for small-signal amplification from dc to low ratio frequencies. They are also useful as oscillators and general-purpose switches. Complementary devices shown where available (Tables 1-4).

NPN	PNP	V(BR)CEO Volts Min	f <sub>T</sub> @ I <sub>C</sub>		I <sub>C</sub> mA Max	h <sub>FE</sub> @ I <sub>C</sub>			NF dB Max	Style
			MHz Min	mA		Min	Max	mA		
<b>Case 29-04 — TO-226AA (TO-92)</b>										
<i><b>MPS8099</b></i>	<i><b>MPS8599</b></i>	80	150	10	500	100	300	1.0	—	1
<i><b>MPSA06</b></i>	<i><b>MPSA56</b></i>	80	100	10	500	100	—	100	—	1
2N4410	—	80	60	10	250	60	400	10	—	1
BC546	BC556	65	150	10	100	120	450	2.0	10	17
BC546A	—	65	150	10	100	120	220	2.0	10	17
BC546B	BC556B	65	150	10	100	180	450	2.0	10	17
MPSA05	MPSA55	60	100	10	500	100	—	100	—	1
—	<i><b>MPS2907A</b></i>	60	200	50	600	100	300	150	—	1
BC182	BC212	50	200 <sup>(1)</sup>	10	100	120	500	2.0	10	14
BC237B	BC307B	45	150	10	100	200	460	2.0	10	17
BC337	BC327	45	210 <sup>(1)</sup>	10	800	100	630	100	—	17
BC547	BC557	45	150	10	100	120	800	2.0	10	17
BC547A	BC557A	45	150	10	100	120	220	2.0	10	17
BC547B	BC557B	45	150	10	100	180	450	2.0	10	17
BC547C	BC557C	45	150	10	100	380	800	2.0	10	17
MPSA20	MPSA70	40	125	5.0	100	40	400	5.0	—	1
<i><b>MPS2222A</b></i>	—	40	300	20	600	100	300	150	—	1
<i><b>2N4401</b></i>	<i><b>2N4403</b></i>	40	200	20	600	100	300	150	—	1
2N4400	2N4402	40	150	20	600	50	150	150	—	1
<i><b>MPS6602</b></i>	<i><b>MPS6652</b></i>	40	100	50	1000	50	—	500	—	1
2N3903	2N3905	40	200	10	200	50	150	10	6.0	1
<i><b>2N3904</b></i>	<i><b>2N3906</b></i>	40	250	10	200	100	300	10	5.0	1
BC548	—	30	300 <sup>(1)</sup>	10	100	110	800	2.0	10	17
BC548A	—	30	300 <sup>(1)</sup>	10	100	120	220	2.0	10	17
BC548B	BC558B	30	300 <sup>(1)</sup>	10	100	200	450	2.0	10	17
BC548C	—	30	300	10	100	420	800	2.0	10	17
2N4123	2N4125	30	200	10	200	50	150	2.0	6.0	1
2N4124	2N4126	25	250	10	200	120	360	2.0	4.0	1
BC338	BC328	25	210 <sup>(1)</sup>	10	800	100	630	100	—	17

(1) Typical

Devices listed in bold, italic are Motorola preferred devices.

## Plastic-Encapsulated Transistors (continued)

**Table 1. Plastic-Encapsulated General-Purpose Transistors (continued)**

NPN	PNP	$V_{(BR)CEO}$ Volts Min	$f_T @ I_C$		$I_C$ A Max	$h_{FE} @ I_C$			$V_{CE(sat)} @ I_C @ I_B$			Style
			MHz Min	mA		Min	Max	mA	Volts Max	mA	mA	
<b>Case 29-05 — TO-226AE (1-WATT TO-92)</b>												
BDC01D	BDB02D	100	50	200	0.5	40	400	100	0.7	1000	100	1
BDC01C	BDB02C	80	50	200	0.5	40	400	100	0.7	1000	100	1
MPS6717		80	50	200	0.5	80	—	50	0.5	250	10	1
<b><i>MPSW06</i></b>	<b><i>MPSW56</i></b>	80	50	200	0.5	80	—	50	0.4	250	10	1

**Table 2. Plastic-Encapsulated Low-Noise and Good  $h_{FE}$  Linearity**

These devices are designed to use on applications where good  $h_{FE}$  linearity and low-noise characteristics are required: Instrumentation, hi-fi preamplifier.

NPN	PNP	$V_{(BR)CEO}$ Volts	$h_{FE} @ I_C$			$V_T^{(4)}$ mV Typ	NF <sup>(5)</sup> dB Max	$f_T$ MHz Typ	Style
			Min	Max	mA				
<b>Case 29-04 — TO-226AA (TO-92)</b>									
—	<b><i>2N5087</i></b>	50	250	800	0.1	—	2.0	40 <sup>(2)</sup>	1
—	2N5086	50	150	500	0.1	—	3.0	40 <sup>(2)</sup>	1
MPS6428	—	50	250	650	0.1	7.0 <sup>(7)</sup>	3.5 <sup>(8)</sup>	100 <sup>(2)</sup>	1
BC239	—	45	120	800	2.0	9.5	2.0 <sup>(1)</sup>	280	17
BC550B	BC560B	45	180	450	2.0	—	2.5	250	17
BC550C	BC560C	45	380	800	2.0	—	2.5	250	17
<b><i>MPSA18</i></b>	—	45	500	—	1.0	6.5 <sup>(1)</sup>	—	160	1
MPS3904	MPS3906	40	100	300	10	—	5.0	200 <sup>(2)</sup>	1
—	MPS4250	40	250	—	10	—	2.0	—	1
BC549B	BC559B	30	200	450	2.0	—	2.5	250	17
BC549C	BC559C	30	380	800	2.0	—	2.5	250	17
2N5088	—	30	350	—	1.0	—	3.0	50	1
2N5089 <sup>(6)</sup>	—	25	450	—	1.0	—	2.0	50	1
<b><i>MPS6521</i></b>	MPS6523	25	300	600	2.0	—	3.0	—	1

(1) Typical

(2) Min

(4)  $V_T$ : Total Input Noise Voltage (see BC413/BC414 and BC415/BC416 Data Sheets) at  $R_S = 2.0 \text{ k}\Omega$ ,  $I_C = 200 \mu\text{A}$ ,  $V_{CE} = 5.0 \text{ Volts}$ .

(5) NF: Noise Figure at  $R_S = 2.0 \text{ k}\Omega$ ,  $I_C = 200 \mu\text{A}$ ,  $V_{CE} = 5.0 \text{ Volts}$ .  $f = 30 \text{ Hz}$  to  $15 \text{ kHz}$ .

(7)  $R_S = 10 \text{ k}\Omega$ ,  $BW = 1.0 \text{ Hz}$ ,  $f = 100 \text{ MHz}$

(8)  $R_S = 500 \Omega$ ,  $BW = 1.0 \text{ Hz}$ ,  $f = 10 \text{ MHz}$

Devices listed in bold, italic are Motorola preferred devices.

## Plastic-Encapsulated Transistors (continued)

**Table 3. Plastic-Encapsulated Darlington Transistors**

Darlington amplifiers are cascade transistors used in applications requiring very high-gain and input impedance. These devices have monolithic construction.

NPN	PNP	V <sub>(BR)CEO</sub> Volts	I <sub>C</sub> Max	hFE @ I <sub>C</sub>			V <sub>CE(sat)</sub> @ I <sub>C</sub> & I <sub>B</sub>			f <sub>T</sub> @ I <sub>C</sub>		Style
				Min	Max	mA	Volts Max	mA	mA	Min	mA	
<b>Case 29-05 — TO-226AE (1-WATT TO-92)</b>												
<b>MPSW45A</b>	—	50	1000	25K	150K	200	1.5	1000	2.0	100	200	1
—	<b>MPSW64</b>	30	1000	20K	—	100	1.5	100	0.1	125	10	1
<b>Case 29-04 — TO-226AA (TO-92)</b>												
<b>MPSA29</b>	—	100	500	10K	—	100	1.5	100	0.1	125	10	1
BC373	—	80	1000	10K	160K	100	1.1	250	0.25	100	100	1
MPSA27	MPSA77	60	500	10K	—	100	1.5	100	0.1	—	—	1
BC618	—	55	1000	10K	50K	200	1.1	200	0.2	150	500	17
—	MPSA75	40	500	10K	—	100	1.5	100	0.1	—	—	1
2N6427	—	40	500	20K	200K	100	1.5	500	0.5	—	—	1
2N6426	—	40	500	30K	300K	100	1.5	500	0.5	125	10	1
<b>MPSA14</b>	<b>MPSA64</b>	30	500	20K	—	100	1.5	100	0.1	125	10	1
MPSA13	MPSA63	30	500	10K	—	100	1.5	100	0.1	125	10	1
BC517	—	30	1000	30K	—	20	1.0	100	0.1	200 <sup>(1)</sup>	10	17

**Table 4. Plastic-Encapsulated High-Current Transistors**

The following table is a listing of devices that are capable of handling a higher current range for small-signal transistors.

NPN	PNP	V <sub>(BR)CEO</sub> Volts Min	f <sub>T</sub> @ I <sub>C</sub>		I <sub>C</sub> mA Max	hFE @ I <sub>C</sub>			V <sub>CE(sat)</sub> @ I <sub>C</sub> & I <sub>B</sub>			Style
			MHz Min	mA		Min	Max	mA	Volts Max	mA	mA	
<b>Case 29-05 — TO-226AE (1-WATT TO-92)</b>												
MPS6715	MPS6727	40	—	—	1000	50	—	1000	0.5	1000	100	1
<b>MPSW01A</b>	<b>MPSW51A</b>	40	50	50	1000	50	—	1000	0.5/0.7	1000	100	1
<b>Case 29-04 — TO-226AA (TO-92)</b>												
BC489	BC490	80	200/150 <sup>(1)</sup>	50	1000	60	400	100	0.3/0.5	1000	100	17
BC639	BC640	80	60	10	500	40	160	150	0.5	500	50	14
<b>MPS651</b>	<b>MPS751</b>	60	75	50	2000	75	—	1000	0.5	2000	200	1
MPS650	MPS750	40	75	50	2000	75	—	1000	0.5	2000	200	1
BC368	BC369	20	65	10	1000	60	—	1000	0.5	1000	100	1

(1) Typical

Devices listed in bold, italic are Motorola preferred devices.

## Plastic-Encapsulated Transistors (continued)

**Table 5. Plastic-Encapsulated High-Voltage Amplifier Transistors**

These high-voltage transistors are designed for driving neon bulbs and indicator tubes, for direct line operation, and for other applications requiring high-voltage capability at relatively low collector current. These devices are listed in order of decreasing breakdown voltage ( $V_{(BR)CEO}$ ).

Device Type	$V_{(BR)CEO}$ Volts Min	$I_C$ Amp Max	$h_{FE} @ I_C$		$V_{CE(sat)} @ I_C \& I_B$			$f_T @ I_C$		Style
			Min	mA	Volts Max	mA	mA	MHz Min	mA	

**Case 29-05 — TO-226AE (1-WATT TO-92) — NPN**

BDC05	300	0.5	40	25	2.0	20	2.0	60	10	14
<b><i>MPSW42</i></b>	300	0.5	40	30	0.5	20	2.0	50	10	1

**Case 29-05 — TO-226AE (1-WATT TO-92) — PNP**

<b><i>MPSW92</i></b>	300	0.5	25	30	0.5	20	2.0	50	10	1
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**Case 29-04 — TO-226AA (TO-92) — NPN**

BF844	400	0.3	50	10	0.5	10	1.0	—	—	1
<b><i>MPSA44</i></b>	400	0.3	40	100	0.75	50	5.0	—	—	1
<b><i>2N6517</i></b>	350	0.5	30	30	0.3	10	1.0	40	10	1
BF393	300	0.5	40	10	0.2	20	2.0	50	10	1
<b><i>MPSA42</i></b>	300	0.5	40	10	0.5	20	2.0	50	10	1
<b><i>2N5551</i></b>	160	0.6	80	10	0.15	10	1.0	100	10	1

**Case 29-04 — TO-226AA (TO-92) — PNP**

BF493S	350	0.5	40	10	20	20	2.0	50	10	1
<b><i>2N6520</i></b>	350	0.5	30	30	0.3	10	1.0	40	10	1
<b><i>MPSA92</i></b>	300	0.5	40	10	0.5	20	2.0	50	10	1
2N6519	300	0.5	45	30	0.3	10	1.0	40	10	1
<b><i>2N5401</i></b>	150	0.6	60	10	0.2	10	1.0	100	10	1

**Case 29-04 — TO-226AA (TO-92)**

NPN	PNP	$V_{(BR)CEO}$ Volts Min	$I_C$ Amp Cont	$h_{FE} @ I_C$		$V_{CE(sat)} @ I_C \& I_B$			$f_T @ I_C$		Style
				Min	mA	Volts Max	mA	mA	MHz Min	mA	
BF420	BF421	300	0.5	50	25	2.0	20	2.0	60	10	14
BF422	BF423	250	0.5	50	25	2.0	20	2.0	60	10	14

Devices listed in bold, italic are Motorola preferred devices.

## Plastic–Encapsulated Transistors (continued)

**Table 6. Plastic–Encapsulated RF Transistors**

The RF transistors are designed for small–signal amplification from RF to VHF/UHF frequencies. They are also used as mixers and oscillators in the same frequency ranges.

Device Type	V(BR)CEO Volts Min	Ic mA Max	hFE @ Ic			fT MHz Typ	CRE/CRB pF Max	NF dB Typ	f MHz	Style
			Min	mA	VCE V					

**Case 29–04 — TO–226AA (TO–92) — NPN**

BF224	30	50	30	7.0	10	600	0.28	2.5	100	21
MPSH24	30	50	30	8.0	10	400(2)	0.36	—	—	2
<b>MPSH20</b>	30	100	25	4.0	10	400(2)	0.65	—	—	2
MPSH07A(9)	30	25	20	3.0	10	400(2)	0.3	3.2(3)	100	1
MPS3866	30	400	10	50	5.0	500(2)	—	—	—	1
<b>MPSH11</b>	25	—	60	4.0	10	650(2)	0.9	—	—	2
<b>MPSH10</b>	25	—	60	4.0	10	650(2)	0.65	—	—	2
BF199	25	100	40	7.0	10	750	0.35	2.5	35	21
BF959	20	100	40	20	10	600(2)	0.65	3.0	200	21
<b>MPSH17</b>	15	—	25	5.0	10	800(2)	0.9	6.0(3)	200	2
<b>MPS918</b>	15	50	20	8.0	10	600(2)	1.7	6.0(3)	60	1
<b>MPS5179</b>	12	50	25	3.0	1.0	2000(3)	—	5.0(3)	200	1
MPS3563	12	50	20	8.0	10	800	1.7	6.0(3)	60	1
<b>MPS6595</b>	12	50	25	10	5.0	1200(2)	1.3	—	—	1

**Case 29–04 — TO–266AA (TO–92) — PNP**

<b>MPSH81</b>	20	50	60	5.0	10	600(2)	0.85	—	—	2
<b>MPSH69</b>	15	50	30	10	10	2000(2)	0.3	—	—	1

**Table 7. Plastic–Encapsulated High–Speed Saturated Switching Transistors**

Device Type	ton & toff @ Ic			V(BR)CEO Volts Min	hFE @ Ic		VCE(sat) @ Ic & IB			fT @ Ic		Style
	ns Max	ns Max	mA		Min	mA	Volts Max	mA	mA	MHz Min	mA	

**Case 29–04 — TO–226AA (TO–92) — NPN**

2N4264	25	35	10	15	40	10	0.22	10	1.0	300	10	1
2N4265	25	35	10	12	100	10	0.22	10	1.0	300	10	1
<b>MPS3646</b>	18	28	300	15	30	30	0.2	30	3.0	350	30	1
<b>MPS2369A</b>	12	18	10	15	40	10	0.2	10	1.0	—	—	1

**Case 29–04 — TO–226AA (TO–92) — PNP**

MPS4258	15	20	10	12	30	50	0.15	10	1.0	700	10	1
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(2) Min

(3) Max

(9) AGC Capable

Devices listed in bold, italic are Motorola preferred devices.

## Plastic-Encapsulated Transistors (continued)

**Table 8. Plastic-Encapsulated Choppers**

Devices are listed in decreasing  $V_{(BR)EBO}$ .

Device Type	$V_{(BR)EBO}$ Volts Min	$I_C$ Amp <sup>(1)</sup> Max	$h_{FE} @ I_C$		$V_{CE(sat)} @ I_C \& I_B$			$f_T @ I_C$		Style
			Min	mA	Volts Max	mA	mA	MHz Min	mA	

**Case 29-04 — TO-226AA (TO-92) — NPN**

<b><i>MPSA17</i></b>	15	100	200	5.0	0.25	10	1.0	80	5.0	1
MPSA16	12	100	200	5.0	0.25	10	1.0	100	5.0	1

**Case 29-04 — TO-266AA (TO-92) — PNP**

<b><i>MPS404A</i></b>	-25	-150	30	-12	-0.2	-24	1.0	—	—	1
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**Table 9. Plastic-Encapsulated Telecom Transistors**

These devices are special product ranges intended for use in telecom applications.

Device Type	$V_{(BR)CEO}$ Volts	$P_D$ mW 25°C Amb	$I_C$ mA Cont	$h_{FE} @ I_C @ V_{CE}$				$f_T$ MHz Min	Style
				Min	Max	mA	Volts		

**Case 29-04 — TO-226AA (TO-92) — NPN**

<b><i>P2N2222A</i></b>	40	625	600	75	—	10	10	300	17
<b><i>PBF259,S</i></b> <sup>(10)</sup>	300	625	500	25	—	1.0	10	40	1

**Case 29-04 — TO-226AA (TO-92) — PNP**

<b><i>P2N2907A</i></b>	60	625	600	100	—	10	10	200	17
<b><i>PBF493,S</i></b> <sup>(11)</sup>	300	625	500	40	—	1.0	10	40	1

(1) Typical

(10) "S" version,  $h_{FE}$  Min 60 @  $I_C = 20$  mA,  $V_{CE} = 10$  V.

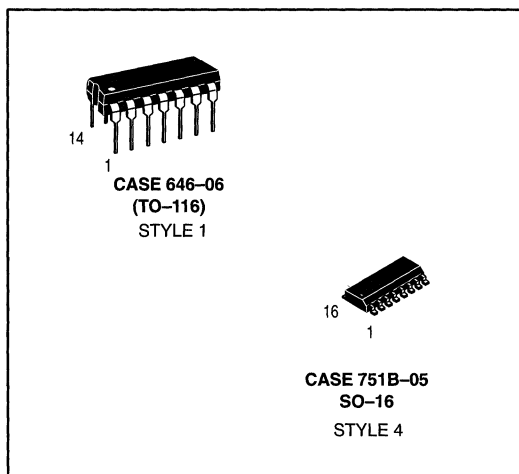
(11) "S" version,  $h_{FE}$  Min 40 @  $I_C = 0.1$  mA,  $V_{CE} = 1.0$  V.

Devices listed in bold, italic are Motorola preferred devices.

# Plastic-Encapsulated Multiple Transistors

The manufacturing trend has been toward printed circuit board design with requirements for smaller packages with more functions. In the case of discrete components the use of the multiple device package helps to reduce board space requirements and assembly costs.

Many of the most popular devices are offered in the standard plastic DIP and surface mount IC packages. This includes small-signal NPN and PNP bipolar transistors, N-channel and P-channel FETs, as well as diode arrays.



## Specification Tables

The following short form specifications include Quad and Dual transistors listed in alphanumeric order. Some columns denote two different types of data indicated by either **bold** or *italic* typeface. See key and headings for proper identification. This applies to Table 10 and 11 of this section only.

<b>KEY</b>											
TYPE NO.	ID	Ref. Point <b>PD</b> Watts <b>One Die Only</b>	Subscript <b>VCE</b> Volts	IC Amp Max	Unit <b>hFE</b> @ IC Min   Max	f <sub>T</sub> MHz Min	C <sub>ob</sub> pF Max	<b>hFE1</b> — <b>hFE2</b>	ΔV <sub>BE</sub> mV Max	G <sub>p</sub> dB Min Max <b>NF</b> @ f dB Max	
Alphanumeric listing type numbers					Common-emitter DC Current Gain.  Units for test Current: A — ampere m — mA u — μA				<i>t<sub>on</sub></i> ns Max	<i>t<sub>off</sub></i> ns Max	V <sub>CE(sat)</sub> @ I <sub>C</sub> Volts   I <sub>B</sub> & I <sub>C</sub> Unit
<b>Identification Code</b>  <b>First Letter: Polarity</b> C — both types in multiple device N — NPN P — PNP  <b>Second Letter: Use</b> A — General Purpose Amplifier E — Low Noise Audio Amplifier F — Low Noise RF Amplifier G — General Purpose Amplifier and Switch H — Tuned RF/IF Amplifier M — Differential Amplifier S — High Speed Switch D — Darlington					Current-Gain-Bandwidth Product  Continuous (DC) Collector Current					G <sub>p</sub> — Power Gain NF — Noise Figure f — Test Frequency AUD — 10–15 kHz Frequency Units: H — Hertz    M — MHz K — kHz     G — GHz  V <sub>CE(sat)</sub> — Collector-Emitter Saturation Voltage I <sub>C</sub> — Test Current Current Units: u — μA m — mA A — Amp	
Power Dissipation specified at 25°C. Single die rating. Ref. Point: A — Ambient Temperature C — Case Temperature				Rated Minimum Collector-Emitter Voltage Subscript letter identifies base termination listed below in order of preference. SUBSCRIPT: 0 — V <sub>CEO</sub> , open				<b>hFE1/hFE2</b> — Current Gain Ratio <b>VBE</b> — Differential Base Voltage  V <sub>BE1</sub> — V <sub>BE2</sub>  . Differential Amplifiers <i>t<sub>on</sub></i> — turn-on time <i>t<sub>off</sub></i> — turn-off time			Output Capacitance, common-base. Shown without distinction: C <sub>cb</sub> — Collector-Base Capacitance C <sub>re</sub> — Common-Emitter Reverse Transfer Capacitance



## Plastic-Encapsulated Multiple Transistors (continued)

**Table 10. Plastic-Encapsulated Multiple Transistors — Quad**

The following table is a listing of the most popular multiple devices available in the plastic DIP package. These devices are available in NPN, PNP, and NPN/PNP configurations. (See note.)

Device	ID	P <sub>D</sub> Watts One Die Only	V <sub>CEO</sub> Volts	I <sub>C</sub> Amp Max	hFE @ I <sub>C</sub>		f <sub>T</sub> MHz Min	C <sub>ob</sub> pF Max	hFE1	ΔV <sub>BE</sub> mV Max	G <sub>p</sub> dB Min	NF dB Max	@ f
					hFE2	t <sub>on</sub> ns Max			t <sub>off</sub> ns Max	V <sub>CE</sub> (sat) Volts Max	NF dB Typ(1) @ I <sub>C</sub>	I <sub>C</sub>	

**Case 646-06 — TO-116**

<i>MPQ2222A</i>	NA	0.65	40	0.5	100	150 m	200	8.0	35(1)	285(1)	0.3	10	150 m
<i>MPQ2369</i>	NS	0.5	15	0.5	40	10 m	450	4.0	9.0(1)	15(1)	0.25	10	10 m
MPQ2483	NA	0.625	40	0.05	150	1.0 m	50					<b>3.0(1)</b>	<b>AUD</b>
<i>MPQ2484</i>	NA	0.625	40	0.05	300	1.0 m	50					<b>2.0(1)</b>	<b>AUD</b>
<i>MPQ2907A</i>	PA	0.65	60	0.6	100	150 m	200	8.0	45(1)	180(1)	0.4	10	150 m
<i>MPQ3467</i>	PS	0.75	40	1.0	20	500 m	125	25	40	90	0.5	10	500 m
<i>MPQ3725</i>	NS	1.0	40	1.0	25	500 m	250	10	35	60	0.45	10	500 m
MPQ3762	PS	0.75	40	1.5	35	150 m	150	15	50	120	0.55	10	500 m
MPQ3798	PA	0.625	40	0.05	150	0.1 m	60	4.0				<b>3.0(1)</b>	<b>AUD</b>
<i>MPQ3799</i>	PA	0.625	60	0.05	300	0.1 m	60	4.0				<b>2.0(1)</b>	<b>AUD</b>
<i>MPQ3904</i>	NG	0.5	40	0.2	75	10 m	250	4.0	37(1)	136(1)	0.2	10	10 m
<i>MPQ3906</i>	PG	0.5	40	0.2	75	10 m	200	4.5	43(1)	155(1)	0.25	10	10 m
MPQ6001	CG	0.65	30	0.5	40	150 m	200	8.0	30(1)	225(1)	0.4	10	150 m
<i>MPQ6002</i>	CG	0.65	30	0.5	100	150 m	200	8.0	30(1)	225(1)	0.4	10	150 m
MPQ6100A	CA	0.5	45	0.05	150	1.0 m	50	4.0				<b>4.0(1)</b>	<b>AUD</b>
MPQ6426	ND	0.5	30	0.5	10K	100 m	125	8.0	—	—	1.5	10	100 m
MPQ6501	CG	0.65	30	0.5	40	150 m	200	8.0	30(1)	225(1)	0.4	10	150 m
MPQ6502	CG	0.65	30	0.5	100	150 m	200	8.0	30(1)	225(1)	0.4	10	150 m
<i>MPQ6600A1</i>	CA	0.5	45	0.05	150	1.0 m	50	4.0	0.8	20	0.25	10	1.0 m
<i>MPQ6700</i>	CA	0.5	40	0.2	70	10 m	200	4.5			0.25	10	1.0 m
MPQ6842	CA	0.75	40	0.5	70	10 m	300	4.5	45	150	0.15	10	0.5 m
<i>MPQ7043</i>	NA	0.75	250	0.5	25	1.0 m	50	5.0			0.5	10	20 m
MPQ7042	NA	0.75	200	0.5	25	1.0 m	50	5.0			0.5	10	20 m
<i>MPQ7051</i>	CG	0.75	150	0.5	25	1.0 m	50	6.0			0.7	10	20 m
<i>MPQ7093</i>	PA	0.75	250	0.5	25	1.0 m	50	5.0			0.5	10	20 m

**Table 11. Plastic-Encapsulated Multiple Transistors — Quad Surface Mount**

The following table is a listing of the most popular multiple devices available in the plastic SOIC surface mount package. These devices are available in NPN, PNP, and NPN/PNP configurations.

Device	V <sub>(BR)CEO</sub>	V <sub>(BR)CBO</sub>	hFE @ I <sub>C</sub>		f <sub>T</sub> @ I <sub>C</sub>	
			Min	mA	MHz Min	mA

**Case 751B-05 — SO-16**

<i>MMPQ2222A</i>	40	75	40	500	200	20
<i>MMPQ2369</i>	15	40	20	100	450	10
<i>MMPQ2907A</i>	50	60	50	500	200	50
<i>MMPQ3467</i>	40	40	20	500	125	50
<i>MMPQ3725</i>	40	60	25	500	250	50
<i>MMPQ3799</i>	60	60	300	0.5	60	1.0
<i>MMPQ3904</i>	40	60	75	10	250	10
<i>MMPQ3906</i>	40	40	75	10	200	10
<i>MMPQ6700(12)</i>	40	40	70	10	200	10

(1) Typical

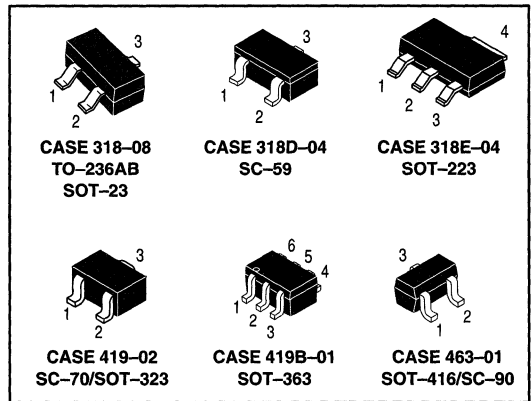
(12) NPN/PNP

NOTE: Some columns show 2 different types of data indicated by either **bold** or *italic* typefaces. See key and headings.

Devices listed in bold, italic are Motorola preferred devices.

# Plastic-Encapsulated Surface Mount Transistors

This section of the selector guide lists the small-signal plastic devices that are available for surface mount applications. These devices are encapsulated with the latest state-of-the-art mold compounds that enhance reliability and exhibit excellent performance in high temperature and high humidity environments. This package offers higher power dissipation capability for small-signal applications.



**Table 12. Plastic-Encapsulated Surface Mount General-Purpose Transistors**

The following tables are a listing of small-signal general-purpose transistors in the SOT-23, SC-59, SOT-223, SC-70, SC-90, and SOT-363 surface mount packages. These devices are intended for small-signal amplification for DC, audio, and lower RF frequencies. They also have applications as oscillators and general-purpose, low voltage switches.

**Pinout: 1-Base, 2-Emitter, 3-Collector**

Devices are listed in order of descending breakdown voltage.

Device	Marking	V <sub>(BR)</sub> CEO	h <sub>FE</sub> @ I <sub>C</sub>			f <sub>T</sub>
			Min	Max	mA	MHz Min
<b>Case 318-08 — TO-236AB (SOT-23) — NPN</b>						
<b>BC846ALT1</b>	1A	65	110	220	2.0	100
<b>BC846BLT1</b>	1B	65	200	450	2.0	100
BC817-16LT1	6A	45	100	250	100	200
BC817-25LT1	6B	45	160	400	100	200
BC817-40LT1	6C	45	250	600	100	200
<b>BC847ALT1</b>	1E	45	110	220	2.0	100
<b>BC847BLT1</b>	1F	45	200	450	2.0	100
<b>BC847CLT1</b>	1G	45	420	800	2.0	100
<b>MMBT2222ALT1</b>	1P	40	100	300	150	200
<b>MMBT3904LT1</b>	1AM	40	100	300	10	200
<b>MMBT4401LT1</b>	2X	40	100	300	150	250
<b>BC848ALT1</b>	1J	30	110	220	2.0	100
<b>BC848BLT1</b>	1K	30	200	450	2.0	100
<b>BC848CLT1</b>	1L	30	420	800	2.0	100
<b>Case 318-08 — TO-236AB (SOT-23) — PNP</b>						
<b>MMBT8599LT1</b>	2W	80	100	300	1.0	150
<b>BC856ALT1</b>	3A	65	125	250	2.0	100
<b>BC856BLT1</b>	3B	65	220	475	2.0	100
<b>MMBT2907ALT1</b>	2F	60	100	300	150	200
BC807-16LT1	5A	45	100	250	100	200
<b>BC807-25LT1</b>	5B	45	160	400	100	200
<b>BC807-40LT1</b>	5C	45	250	600	100	200
<b>BC857ALT1</b>	3E	45	125	250	2.0	100
<b>BC857BLT1</b>	3F	45	220	475	2.0	100
<b>MMBT3906LT1</b>	2A	40	100	300	10	250
<b>MMBT4403LT1</b>	2T	40	100	300	150	200
<b>BC858ALT1</b>	3J	30	125	250	2.0	100
<b>BC858BLT1</b>	3K	30	220	475	2.0	100
<b>BC858CLT1</b>	3L	30	420	800	2.0	100

Devices listed in bold, italic are Motorola preferred devices.

## Plastic-Encapsulated Surface Mount Transistors (continued)

Table 12. Plastic-Encapsulated Surface Mount General-Purpose Transistors (continued)

Pinout: 1-Base, 2-Emitter, 3-Collector

Devices are listed in order of descending breakdown voltage.

Device	Marking	$V_{(BR)CEO}$	$h_{FE} @ I_C$			$f_T$ MHz Min
			Min	Max	mA	
<b>Case 318D-04 — SC-59 — NPN</b>						
<i>MSD601-RT1</i>	YR	25	210	340	2.0	150 <sup>(1)</sup>
MSD601-ST1	YS	25	290	460	2.0	150 <sup>(1)</sup>
<i>MSD602-RT1</i>	WR	25	120	240	150	200 <sup>(1)</sup>
MSD1328-RT1	1DR	20	200	350	500	200 <sup>(1)</sup>
<b>Case 318D-04 — SC-59 — PNP</b>						
<i>MSB709-RT1</i>	AR	25	210	340	2.0	100 <sup>(1)</sup>
MSB709-ST1	AS	25	290	460	2.0	100 <sup>(1)</sup>
MSB710-QT1	CQ	25	85	170	150	200 <sup>(1)</sup>
<i>MSB710-RT1</i>	CR	25	120	240	150	200 <sup>(1)</sup>
<b>Case 419-02 — SC-70/SOT-323 —NPN</b>						
<i>BC818WT1</i>	6I	45	100	600	100	—
<i>BC818-25WT1</i>	6F	45	160	400	100	—
<i>BC818-40WT1</i>	6G	45	250	600	100	—
<i>BC846AWT1</i>	1A	65	110	220	2.0	100
<i>BC846BWT1</i>	1B	65	200	450	2.0	100
<i>BC847AWT1</i>	1E	45	110	220	2.0	100
<i>BC847BWT1</i>	1F	45	200	450	2.0	100
<i>BC847CWT1</i>	1G	45	420	800	2.0	100
<i>BC848AWT1</i>	1J	30	110	220	2.0	100
<i>BC848BWT1</i>	1K	30	200	450	2.0	100
<i>BC848CWT1</i>	1L	30	420	800	2.0	100
<i>MMBT2222AWT1</i>	1P	40	100	300	150	300
<i>MMBT3904WT1</i>	AM	40	100	300	10	300
<i>MSC3930-BT1</i>	VB	20	70	140	1.0	150
<i>MSD1819A-RT1</i>	ZR	50	210	340	2.0	—
<b>Case 419-02 — SC-70/SOT-323 —PNP</b>						
<i>BC808-25WT1</i>	5F	45	160	400	100	—
<i>BC808-40WT1</i>	6F	45	250	600	100	—
<i>BC856AWT1</i>	3A	65	125	250	2.0	100
<i>BC856BWT1</i>	3B	65	220	475	2.0	100
<i>BC857AWT1</i>	3E	45	125	250	2.0	100
<i>BC857BWT1</i>	3F	45	220	475	2.0	100
<i>BC858AWT1</i>	3J	30	110	220	2.0	100
<i>BC858BWT1</i>	3K	30	200	450	2.0	100
<i>BC858CWT1</i>	3L	30	420	800	2.0	100
<i>MMBT2907AWT1</i>	20	60	100	300	150	200
<i>MMBT3906WT1</i>	2A	40	100	300	10	250
<i>MSB1218A-RT1</i>	BR	45	210	340	2.0	—
<b>Case 419B-01 — SOT-363 — Dual NPN</b>						
<i>MBT3904DW1T1</i>	MA	40	100	300	10	300
<i>MBT3904DW9T1</i>	MB	40	100	300	10	300
<b>Case 419B-01 — SOT-363 — Dual PNP</b>						
<i>MBT3906DW1T1</i>	A2	-40	100	300	10	250
<i>MBT3906DW9T1</i>	A3	-40	100	300	10	250

(1) Typical

Devices listed in bold, italic are Motorola preferred devices.

## Plastic–Encapsulated Surface Mount Transistors (continued)

**Table 12. Plastic–Encapsulated Surface Mount General–Purpose Transistors (continued)**

Pinout: 1–Base, 2–Emitter, 3–Collector

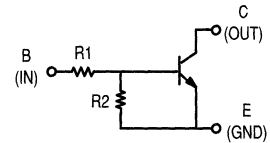
Devices are listed in order of descending breakdown voltage.

Device	Marking	$V_{(BR)CEO}$	$h_{FE} @ I_C$			$f_T$ MHz Min
			Min	Max	mA	
<b>Case 419B–01 — SOT–363 — Dual Combination NPN and PNP</b>						
<i>MBT3946DW1T1</i>	46	40	100	300	10	250
<b>Case 463–01 — SOT–416/SC–90 — NPN</b>						
<i>2SC4617</i>	B9	50	120	560	1.0	180
<b>Case 463–01 — SOT–416/SC–90 — PNP</b>						
<i>2SA1774</i>	F9	50	120	560	1.0	140

**Table 13. Plastic–Encapsulated Surface Mount Bias Resistor Transistors for General Purpose Applications**

Pinout: 1–Base, 2–Emitter, 3–Collector

These devices include bias resistors on the semiconductor chip with the transistor. See the BRT diagram for orientation of resistors.



Device		Marking		$V_{(BR)CEO}$ Volts (Min)	$h_{FE} @ I_C$		$I_C$ mA Max	$R_1$ Ohm	$R_2$ Ohm
NPN	PNP	NPN	PNP		Min	mA			
<b>Case 318D–04 — SC–59</b>									
<i>MUN2211T1</i>	<i>MUN2111T1</i>	8A	6A	50	35	5.0	100	10K	10K
<i>MUN2212T1</i>	<i>MUN2112T1</i>	8B	6B	50	60	5.0	100	22K	22K
<i>MUN2213T1</i>	<i>MUN2113T1</i>	8C	6C	50	80	5.0	100	47K	47K
<i>MUN2214T1</i>	<i>MUN2114T1</i>	8D	6D	50	80	5.0	100	10K	47K
<i>MUN2215T1</i>	<i>MUN2115T1</i>	8E	6E	50	160	5.0	100	10K	∞
<i>MUN2216T1</i>	<i>MUN2116T1</i>	8F	6F	50	160	5.0	100	4.7K	∞
<i>MUN2230T1</i>	<i>MUN2130T1</i>	8G	6G	50	3.0	5.0	100	1.0K	1.0K
<i>MUN2231T1</i>	<i>MUN2131T1</i>	8H	6H	50	8.0	5.0	100	2.2K	2.2K
<i>MUN2232T1</i>	<i>MUN2132T1</i>	8J	6J	50	15	5.0	100	4.7K	4.7K
<i>MUN2233T1</i>	<i>MUN2133T1</i>	8K	6K	50	80	5.0	100	4.7K	47K
<i>MUN2234T1</i>	<i>MUN2134T1</i>	8L	6L	50	80	5.0	100	22K	47K

**Case 318–08 — TO–236AB (SOT–23)**

<i>MMUN2211LT1</i>	<i>MMUN2111LT1</i>	A8A	A6A	50	35	5.0	100	10K	10K
<i>MMUN2212LT1</i>	<i>MMUN2112LT1</i>	A8B	A6B	50	60	5.0	100	22K	22K
<i>MMUN2213LT1</i>	<i>MMUN2113LT1</i>	A8C	A6C	50	80	5.0	100	47K	47K
<i>MMUN2214LT1</i>	<i>MMUN2114LT1</i>	A8D	A6D	50	80	5.0	100	10K	47K
<i>MMUN2215LT1</i>	<i>MMUN2115LT1</i>	A8E	A6E	50	160	5.0	100	10K	∞
<i>MMUN2216LT1</i>	<i>MMUN2116LT1</i>	A8F	A6F	50	160	5.0	100	4.7K	∞
<i>MMUN2230LT1</i>	<i>MMUN2130LT1</i>	A8G	A6G	50	3.0	5.0	100	1.0K	1.0K
<i>MMUN2231LT1</i>	<i>MMUN2131LT1</i>	A8H	A6H	50	8.0	5.0	100	2.2K	2.2K
<i>MMUN2232LT1</i>	<i>MMUN2132LT1</i>	A8J	A6J	50	15	5.0	100	4.7K	4.7K
<i>MMUN2233LT1</i>	<i>MMUN2133LT1</i>	A8K	A6K	50	80	5.0	100	4.7K	47K
<i>MMUN2234LT1</i>	<i>MMUN2134LT1</i>	A8L	A6L	50	80	5.0	100	22K	47K

Devices listed in bold, italic are Motorola preferred devices.

## Plastic-Encapsulated Surface Mount Transistors (continued)

Table 13. Plastic-Encapsulated Surface Mount Bias Resistor Transistors for General Purpose Applications (continued)

Pinout: 1-Base, 2-Emitter, 3-Collector

Device		Marking		V(BR)CEO Volts (Min)	hFE @ IC		IC mA Max	R1 Ohm	R2 Ohm
NPN	PNP	NPN	PNP		Min	mA			
<b>Case 419-02 — SC-70/SOT-323</b>									
<i>MUN5211T1</i>	<i>MUN5111T1</i>	8A	6A	50	35	5.0	50	10K	10K
<i>MUN5212T1</i>	<i>MUN5112T1</i>	8B	6B	50	60	5.0	50	22K	22K
<i>MUN5213T1</i>	<i>MUN5113T1</i>	8C	6C	50	80	5.0	50	47K	47K
<i>MUN5214T1</i>	<i>MUN5114T1</i>	8D	6D	50	80	5.0	50	10K	47K
<i>MUN5215T1</i>	<i>MUN5115T1</i>	8E	6E	50	160	5.0	50	10K	∞
<i>MUN5216T1</i>	<i>MUN5116T1</i>	8F	6F	50	160	5.0	50	4.7K	∞
<i>MUN5230T1</i>	<i>MUN5130T1</i>	8G	6G	50	3.0	5.0	50	1.0K	1.0K
<i>MUN5231T1</i>	<i>MUN5131T1</i>	8H	6H	50	8.0	5.0	50	2.2K	2.2K
<i>MUN5232T1</i>	<i>MUN5132T1</i>	8J	6J	50	15	5.0	50	4.7K	4.7K
<i>MUN5233T1</i>	<i>MUN5133T1</i>	8K	6K	50	80	5.0	50	4.7K	47K
<i>MUN5234T1</i>	<i>MUN5134T1</i>	8L	6L	50	80	5.0	50	22K	47K

<b>Case 419B-01 — SOT-363 Duals</b>									
Device	Marking	V(BR)CEO	hFE @ IC	IC	R1	R2			
			Min	mA	Ohm	Ohm			
<i>MUN5211DW1T1</i>	<i>MUN5111DW1T1</i>	7A	8A	50	35	5.0	100	10K	10K
<i>MUN5212DW1T1</i>	<i>MUN5112DW1T1</i>	7B	8B	50	60	5.0	100	22K	22K
<i>MUN5213DW1T1</i>	<i>MUN5113DW1T1</i>	7C	8C	50	80	5.0	100	47K	47K
<i>MUN5214DW1T1</i>	<i>MUN5114DW1T1</i>	7D	8D	50	80	5.0	100	10K	47K
<i>MUN5215DW1T1</i>	<i>MUN5115DW1T1</i>	7E	8E	50	160	5.0	100	10K	∞
<i>MUN5216DW1T1</i>	<i>MUN5116DW1T1</i>	7F	8F	50	160	5.0	100	4.7K	∞
<i>MUN5230DW1T1</i>	<i>MUN5130DW1T1</i>	7G	8G	50	3.0	5.0	100	1.0K	1.0K
<i>MUN5231DW1T1</i>	<i>MUN5131DW1T1</i>	7H	8H	50	8.0	5.0	100	2.2K	2.2K
<i>MUN5232DW1T1</i>	<i>MUN5132DW1T1</i>	7J	8J	50	15	5.0	100	4.7K	4.7K
<i>MUN5233DW1T1</i>	<i>MUN5133DW1T1</i>	7K	8K	50	80	5.0	100	4.7K	47K
<i>MUN5234DW1T1</i>	<i>MUN5134DW1T1</i>	7L	8L	50	80	5.0	100	22K	47K
<i>MUN5235DW1T1</i>	<i>MUN5135DW1T1</i>	7M	8M	50	80	5.0	100	2.2K	47K

Device	Marking	V(BR)CEO	hFE @ IC		IC mA Max	R1 Ohm	R2 Ohm
			Min	mA			

Case 419B-01 — SOT-363 — Dual Combination NPN and PNP

<i>MUN5311DW1T1</i>	11	50	35	5.0	100	10K	10K
<i>MUN5312DW1T1</i>	12	50	60	5.0	100	22K	22K
<i>MUN5313DW1T1</i>	13	50	80	5.0	100	47K	47K
<i>MUN5314DW1T1</i>	14	50	80	5.0	100	10K	47K
<i>MUN5315DW1T1</i>	15	50	160	5.0	100	10K	∞
<i>MUN5316DW1T1</i>	16	50	160	5.0	100	4.7K	∞
<i>MUN5330DW1T1</i>	3X	50	3.0	5.0	100	1.0K	1.0K
<i>MUN5331DW1T1</i>	31	50	8.0	5.0	100	2.2K	2.2K
<i>MUN5332DW1T1</i>	32	50	15	5.0	100	4.7K	4.7K
<i>MUN5333DW1T1</i>	33	50	80	5.0	100	4.7K	47K
<i>MUN5334DW1T1</i>	34	50	80	5.0	100	22K	47K
<i>MUN5335DW1T1</i>	35	50	80	5.0	100	2.2K	47K

Device		Marking		V(BR)CEO Volts (Min)	hFE @ IC		IC mA Max	R1 Ohm	R2 Ohm
NPN	PNP	NPN	PNP		Min	mA			

Case 463-01 — SOT-416/SC-90

<i>DTC114TE</i>	—	94	—	50	100	1.0	100	10K	∞
<i>DTC114YE</i>	<i>DTA114YE</i>	69	59	50	80	5.0	100	10K	47K
—	<i>DTA143EE</i>	—	43	50	15	5.0	100	4.7K	4.7K

Devices listed in bold, italic are Motorola preferred devices.

## Plastic–Encapsulated Surface Mount Transistors (continued)

**Table 14. Plastic–Encapsulated Surface Mount Switching Transistors**

The following tables are a listing of devices intended for high–speed, low saturation voltage, switching applications. These devices have very fast switching times and low output capacitance for optimized switching performance.

**Pinout: 1–Base, 2–Emitter, 3–Collector**

Device	Marking	Switching Time (ns)		$V_{(BR)CEO}$	$h_{FE} @ I_C$			$f_T$ MHz Min
		$t_{on}$	$t_{off}$		Min	Max	mA	
<b>Case 318–08 — TO–236AB (SOT–23) — NPN</b>								
<i>MMBT2369LT1</i>	M1J	12	18	15	20	—	100	—
<i>MMBT2369ALT1</i>	1JA	12	18	15	20	—	100	—
BSV52LT1	B2	12	18	12	40	120	10	400
<b>Case 318–08 — TO–236AB (SOT–23) — PNP</b>								
<i>MMBT3640LT1</i>	2J	25	35	12	20	—	50	500

**Pinout: 1–Emitter, 2–Base, 3–Collector**

**Case 318D–04 — SC–59 — NPN**

MSC1621T1	RB	20	40	20	40	180	1.0	200
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**Table 15. Plastic–Encapsulated Surface Mount VHF/UHF Amplifiers, Mixers, Oscillators**

The following table is a listing of devices intended for small–signal RF amplifier applications to VHF/UHF frequencies. These devices may also be used as VHF/UHF oscillators and mixers.

**Pinout: 1–Base, 2–Emitter, 3–Collector**

Device	Marking	$V_{(BR)CEO}$	$C_{cb}^{(13)}$ pF Max	$f_T @ I_C$	
				GHz Min	mA
<b>Case 318–08 — TO–236AB (SOT–23) — NPN</b>					
<i>MMBTH10LT1</i>	3EM	25	0.7	0.65	4.0
<i>MMBT918LT1</i>	M3B	15	1.7 <sup>(14)</sup>	0.6	4.0
<i>MMBTH24LT1</i>	M3A	30	0.45	0.4	8.0
<b>Case 318–08 — TO–236AB (SOT–23) — PNP</b>					
<i>MMBTH81LT1</i>	3D	20	0.85	0.6	5.0
<i>MMBTH69LT1</i>	M3J	15	0.35 <sup>(13)</sup>	2.0	10

**Pinout: 1–Emitter, 2–Base, 3–Collector**

**Case 318D–04 — SC–59 — NPN**

<i>MSC2295–BT1</i>	VB	20	1.5 <sup>(13)</sup>	0.15	1.0
<i>MSC2295–CT1</i>	VC	20	1.5 <sup>(13)</sup>	0.15	1.0
<i>MSC2404–CT1</i>	UC	20	1.0 <sup>(13)</sup>	0.45	1.0
<i>MSC3130T1</i>	1S	10	—	1.4	5.0

**Case 318D–04 — SC–59 — PNP**

<i>MSA1022–BT1</i>	EB	20	2.0 <sup>(13)</sup>	0.15	1.0
<i>MSA1022–CT1</i>	EC	20	2.0 <sup>(13)</sup>	0.15	1.0

**Case 419–02 — SC–70/SOT–323 — PNP**

<i>MSB81T1</i>	J3D	20	0.85 <sup>(13)</sup>	0.6	5.0
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<sup>(13)</sup>  $C_{re}$

<sup>(14)</sup>  $C_{ob}$

Devices listed in bold, italic are Motorola preferred devices.

## Plastic-Encapsulated Surface Mount Transistors (continued)

**Table 16. Plastic-Encapsulated Surface Mount Choppers**

The following table is a listing of small-signal devices intended for chopper applications where a higher than normal  $V_{(BR)CEO}$  is required in the circuit application.

**Pinout: 1-Base, 2-Emitter, 3-Collector**

Device	Marking	$V_{(BR)CEO}$	$V_{(BR)EBO}$	$h_{FE} @ I_C$		
				Min	Max	mA
<b>Case 318-08 — TO-236AB (SOT-23) — PNP</b>						
<b><i>MMBT404ALT1</i></b>	2N	35	25	30	400	12

**Table 17. Plastic-Encapsulated Surface Mount Darlington**

The following table is a listing of small-signal devices that have very high  $h_{FE}$  and input impedance characteristics. These devices utilize monolithic, cascade transistor construction.

**Pinout: 1-Base, 2-Emitter, 3-Collector**

Devices are listed in order of descending  $h_{FE}$ .

Device	Marking	$V_{(BR)CES}$	$V_{CE(sat)}$ Volts Max	$h_{FE} @ I_C$		
				Min	Max	mA
<b>Case 318-08 — TO-236AB (SOT-23) — NPN</b>						
<b><i>MMBTA14LT1</i></b>	1N	30	1.5	20K	—	100
<b><i>MMBTA13LT1</i></b>	1M	30	1.5	10K	—	100
<b>Case 318-08 — TO-236AB (SOT-23) — PNP</b>						
<b><i>MMBTA64LT1</i></b>	2V	30	1.5	20K	—	100

**Table 18. Plastic-Encapsulated Surface Mount Low-Noise Transistors**

The following table is a listing of small-signal devices intended for low noise applications in the audio range. These devices exhibit good linearity and are candidates for hi-fi and instrumentation equipment.

**Pinout: 1-Base, 2-Emitter, 3-Collector**

Devices are listed in order of ascending NF.

Device	Marking	NF dB Typ	$V_{(BR)CEO}$	$h_{FE} @ I_C$			$f_T$ MHz Min
				Min	Max	mA	
<b>Case 318-08 — TO-236AB (SOT-23) — NPN</b>							
<b><i>MMBT5089LT1</i></b>	1R	2.0(15)	25	400	—	10	50
<b><i>MMBT2484LT1</i></b>	1U	3.0(15)	60	—	800	10	—
<b><i>MMBT6428LT1</i></b>	1KM	3.0	50	250	—	10	100
<b><i>MMBT6429LT1</i></b>	1L	3.0	45	500	—	10	100
<b>Case 318-08 — TO-236AB (SOT-23) — PNP</b>							
<b><i>MMBT5087LT1</i></b>	2Q	2.0(15)	50	250	—	10	40

(15) Max

Devices listed in bold, italic are Motorola preferred devices.

## Plastic-Encapsulated Surface Mount Transistors (continued)

**Table 19. Plastic-Encapsulated Surface Mount High-Voltage Transistors**

The following table is a listing of small-signal high-voltage devices designed for direct line operation requiring high voltage breakdown and relatively low current capability.

**Pinout: 1-Base, 2-Emitter, 3-Collector**

Devices are listed in order of descending breakdown voltage.

Device	Marking	$V_{(BR)CEO}$	$h_{FE@ IC}$			$f_T$ MHz Min
			Min	Max	mA	
<b>Case 318-08 — TO-236AB (SOT-23) — NPN</b>						
<i>MMBT6517LT1</i>	1Z	350	15	—	100	40
<i>MMBTA42LT1</i>	1D	300	40	—	30	50
<i>MMBT5551LT1</i>	G1	160	30	—	50	100
<b>Case 318-08 — TO-236AB (SOT-23) — PNP</b>						
<i>MMBT6520LT1</i>	2Z	350	15	—	100	40
<i>MMBTA92LT1</i>	2D	300	25	—	30	50
<i>MMBT5401LT1</i>	2L	150	50	—	50	100

**Table 20. Plastic-Encapsulated Surface Mount Drivers**

The following is a listing of small-signal devices intended for medium voltage driver applications at fairly high current levels.

**Pinout: 1-Base, 2-Emitter, 3-Collector**

Device	Marking	$V_{(BR)CEO}$	$V_{CE(sat)}$	$V_{BE(sat)}$	$h_{FE@ IC}$		
					Min	Max	mA
<b>Case 318-08 — TO-236AB (SOT-23) — NPN</b>							
<i>MMBTA06LT1</i>	1GM	80	0.25	—	100	—	100
<i>BSS64LT1</i>	AM	80	0.15	—	20	—	10
<b>Case 318-08 — TO-236AB (SOT-23) — PNP</b>							
<i>BSS63LT1</i>	T1	100	-0.25	-0.90	30	—	25
<i>MMBTA56LT1</i>	2GM	80	-0.25	—	100	—	100

The following devices are designed to conserve energy. They offer ultra-low collector saturation voltage.

**Case 318-08 — TO-236AB (SOT-23) — PNP**

<i>MMBT1010LT1</i>	GLP	15	0.1	1.1	300	600	100
<b>Case 318-03 — SC-59 — PNP</b>							
<i>MSD1010T1</i>	GLP	15	0.1	1.1	300	600	100

**Table 21. Plastic-Encapsulated Surface Mount General Purpose Amplifiers**

**Pinout: 1-Base, 2-Collector, 3-Emitter, 4-Collector**

Device	Marking	$V_{(BR)CEO}$	$h_{FE@ IC}$		
			Min	Max	mA
<b>Case 318E-04 — SOT-223 — NPN</b>					
<i>BCP56T1</i>	BH	80	40	250	150
<b>Case 318E-04 — SOT-223 — PNP</b>					
<i>BCP53T1</i>	AH	80	40	25	150

Devices listed in bold, italic are Motorola preferred devices.



## Plastic-Encapsulated Surface Mount Transistors (continued)

**Table 22. Plastic-Encapsulated Surface Mount Switching Transistors**  
Pinout: 1-Base, 2-Collector, 3-Emitter, 4-Collector

Device	Marking	$t_{on}$	$t_{off}$	$V_{(BR)CEO}$	$h_{FE}$		$f_T$	
					Min	Max	@ $I_C$ (mA)	Min (MHz)
<b>Case 318E-04 — SOT-223 — NPN</b>								
<i>PZT2222AT1</i>	P1F	35	285	40	100	300	20	300
<b>Case 318E-04 — SOT-223 — PNP</b>								
<i>PZT2907AT1</i>	P2F	45	100	60	100	300	50	200

**Table 23. Plastic-Encapsulated Surface Mount Darlingtons**  
Pinout: 1-Base, 2-Collector, 3-Emitter, 4-Collector

Device	Marking	$V_{(BR)CER}$	$V_{CE(sat)}$ Max (V)	$h_{FE}$		@ $I_C$ (mA)
				Min	Max	
<b>Case 318E-04 — SOT-223 — NPN</b>						
<i>BSP52T1</i>	AS3	80	1.3	2000	—	500
<i>PZTA14T1</i>	P1N	30	1.5	20k	—	100
<b>Case 318E-04 — SOT-223 — PNP</b>						
<i>BSP62T1</i>	BS3	90	1.3	2000	—	500
<i>PZTA64T1</i>	P2V	30	1.5	20k	—	100

**Table 24. Plastic-Encapsulated Surface Mount High-Voltage Transistors**  
Pinout: 1-Base, 2-Collector, 3-Emitter, 4-Collector

Device	Marking	$V_{(BR)CEO}$	$h_{FE}$		$f_T$	
			Min	Max	@ $I_C$ (mA)	Min (MHz)
<b>Case 318E-04 — SOT-223 — NPN</b>						
<i>BSP19AT1</i>	SP19A	350	40	—	20	70
<i>PZTA42T1</i>	P1D	300	40	—	10	50
<i>BF720T1</i>	BF720	250	50	—	10	60
<i>BSP20AT1</i>	SP20A	250	40	—	20	70
<b>Case 318E-04 — SOT-223 — PNP</b>						
<i>PZTA96T1</i>	ZTA96	450	50	150	10	50
<i>PZTA92T1</i>	P2D	300	40	—	10	50
<i>BSP16T1</i>	BSP16	300	30	150	10	15
<i>BF721T1</i>	BF721	250	50	—	10	60

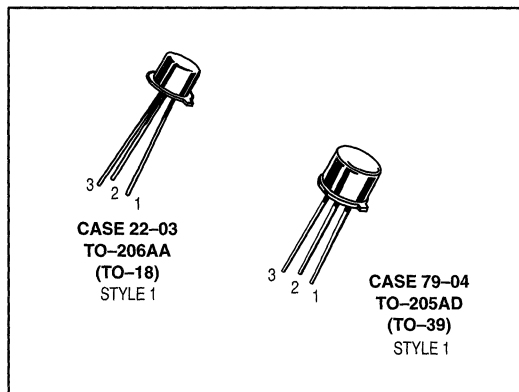
**Table 25. Plastic-Encapsulated Surface Mount High Current Transistors**  
Pinout: 1-Base, 2-Collector, 3-Emitter, 4-Collector

Device	Marking	$V_{(BR)CEO}$	$V_{CE(sat)}$ Volts	$h_{FE} @ I_C$		
				Min	Max	mA
<b>Case 318E-04 — SOT-223 — NPN</b>						
<i>PZT651T1</i>	651	60	0.5	75	—	1000
<i>BCP68T1</i>	CA	20	0.5	60	—	1000
<b>Case 318E-04 — SOT-223 — PNP</b>						
<i>PZT751T1</i>	ZT751	60	0.5	75	—	1000
<i>BCP69T1</i>	CE	20	0.5	60	—	1000

Devices listed in bold, italic are Motorola preferred devices.

# Metal-Can Transistors

Metal-can packages are intended for use in industrial applications where harsh environmental conditions are encountered. These packages enhance reliability of the end products due to their resistance to varying humidity and extreme temperature ranges.



**Table 26. Metal-Can General-Purpose Transistors**

These transistors are designed for DC to VHF amplifier applications, general-purpose switching applications, and complementary circuitry. Devices are listed in decreasing order of  $V_{(BR)CEO}$  within each package group.

Device Type	$V_{(BR)CEO}$ Volts Min	$f_T @ I_C$		$I_C$ mA Max	$h_{FE} @ I_C$		
		MHz Min	mA		Min	Max	mA
<b>Case 22-03 — TO-206AA (TO-18) — NPN</b>							
<b>2N3700</b>	80	80	50	1000	50	—	500
BC107	45	150	10	200	110	450	2.0
BC107B	45	150	10	200	200	450	2.0
<b>2N2222A</b>	40	300	20	800	100	300	150
BC109C	25	150	10	200	420	800	2.0
<b>Case 22-03 — TO-206AA (TO-18) — PNP</b>							
2N2906A	60	200	50	600	40	120	150
<b>2N2907A</b>	60	200	50	600	100	300	150
<b>2N3251A</b>	60	300	10	200	100	300	10
BC177B	45	200	10	200	180	460	2.0
<b>Case 79-04 — TO-205AD (TO-39) — NPN</b>							
<b>2N3019</b>	80	100	50	1000	100	300	150
2N3020	80	80	50	1000	40	120	150
2N1893	80	50	50	500	40	120	150
<b>2N2219A</b>	40	300	20	800	100	300	150
<b>Case 79-04 — TO-205AD (TO-39) — PNP</b>							
2N4033	80	—	—	1000	25	—	1000
2N4036	65	60	50	1000	40	140	150
2N2904A	60	200	50	600	40	120	150
<b>2N2905A</b>	60	200	50	600	100	300	150
2N4032	60	—	—	1000	40	—	1000

Devices listed in bold, italic are Motorola preferred devices.

## Metal-Can Transistors (continued)

**Table 27. Metal-Can High-Gain/Low-Noise Transistors**

These transistors are characterized for high-gain and low-noise applications. Devices are listed in decreasing order of NF.

Device Type	NF Wideband dB Typ Max	V <sub>(BR)CEO</sub> Volts Min	I <sub>C</sub> mA Max	hFE @ I <sub>C</sub>			f <sub>T</sub> @ I <sub>C</sub>	
				Min	Max	μA mA	MHz Min	mA

**Case 22-03 — TO-206AA (TO-18) — NPN**

<b>2N2484</b>	8.0(1)	60	50	100	500	10	15	0.05
2N930A	3.0	45	30	—	600	10	45	0.5
2N930	3.0	45	30	—	600	10	30	0.5

**Case 22-03 — TO-206AA (TO-18) — PNP**

<b>2N3964</b>	4.0	45	200	250	600	1.0(24)	50	0.5
<b>2N3799</b>	2.5	60	50	300	900	500	30	0.5

**Table 28. Metal-Can High-Voltage/High-Current Transistors**

The following table lists Motorola standard devices that have high collector-emitter breakdown voltage. Devices are listed in decreasing order of V<sub>(BR)CEO</sub> within each package type.

Device Type	V <sub>(BR)CEO</sub> Volts Min	I <sub>C</sub> mA Max	hFE @ I <sub>C</sub>		V <sub>CE(sat)</sub> @ I <sub>C</sub> & I <sub>B</sub>			f <sub>T</sub> @ I <sub>C</sub>	
			Min	mA	Volts Max	mA	mA	MHz Min	mA

**Case 22-03 — TO-206AA (TO-18) — NPN**

<b>2N6431</b>	300	50	50	30	0.5	20	2.0	50	10
BSS73	300	500	40	30	1.0	50	5.0	50	20

**Case 22-03 — TO-206AA (TO-18) — PNP**

BSS76	300	500	35	30	0.5	50	5.0	50	20
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**Case 79-04 — TO-205AD (TO-39) — PNP**

2N3637	175	1000	100	50	0.5	50	5.0	200	30
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(1) Typical  
(24) T<sub>A</sub> = 25°C

**Table 29. Metal-Can Switching Transistors**

The following devices are intended for use in general-purpose switching and amplifier applications. Within each package group shown, the devices are listed in order of decreasing turn-on time (t<sub>on</sub>).

Device Type	t <sub>on</sub> & t <sub>off</sub> @ I <sub>C</sub>			V <sub>(BR)CEO</sub> Volts Min	I <sub>C</sub> mA Max	hFE @ I <sub>C</sub>		V <sub>CE(sat)</sub> @ I <sub>C</sub> @ I <sub>B</sub>			f <sub>T</sub> MHz Min	I <sub>C</sub> mA
	ns Max	ns	mA			Min	mA	Volts Max	mA	mA		

**Case 22-03 — TO-206AA (TO-18) — NPN**

<b>2N2369A</b>	12	18	10	15	200	40	10	0.2	10	1.0	500	10
BSX20	7.0	21	100	15	500	20	10	0.25	10	1.0	500	10

**Case 79-04 — TO-205AD (TO-39) — PNP**

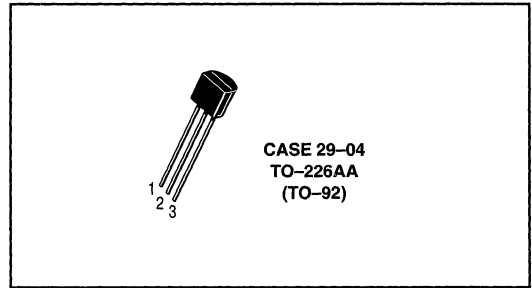
<b>2N3467</b>	40	90	500	40	1000	40	500	0.5	500	50	175	50
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Devices listed in bold, italic are Motorola preferred devices.

# Field-Effect Transistors

## JFETs

JFETs operate in the depletion mode. They are available in both P- and N-channel and are offered in both Through-hole and Surface Mount packages. Applications include general-purpose amplifiers, switches and choppers, and RF amplifiers and mixers. These devices are economical and very rugged. The drain and source are interchangeable on many typical FETs.



**Table 30. JFET Low-Frequency/Low-Noise**

The following table is a listing of small-signal JFETs intended for low-noise applications in the audio range. These devices exhibit good linearity and are candidates for hi-fi and instrumentation equipment.

Device	$R_e  Y_{fs}  @ f$		$R_e  Y_{os}  @ f$		$C_{iss}$ pF Max	$C_{rss}$ pF Max	$V_{(BR)GSS}$ $V_{(BR)GDO}$ Volts Min	$V_{GS(off)}$ Volts		$I_{DSS}$ mA		Style
	mmho Min	kHz	$\mu$ mho Max	kHz				Min	Max	Min	Max	

**Case 29-04 — TO-226AA (TO-92) — N-Channel**

J202	—	—	—	—	—	—	40	0.8	4.0	0.9	4.5	5
<b>2N5458</b>	1.5	1.0	50	1.0	7.0	3.0	25	1.0	7.0	2.0	9.0	5
MPF3821	1.5	1.0	10	1.0	6.0	3.0	50	—	4.0	0.5	2.5	5
<b>2N5457</b>	1.0	1.0	50	1.0	7.0	3.0	25	0.5	6.0	1.0	5.0	5
<b>2N5459</b>	2.0	1.0	50	1.0	7.0	3.0	25	2.0	8.0	4.0	16	5

**Case 29-04 — TO-226AA (TO-92) — P-Channel**

<b>2N5460</b>	1.0	1.0	75	1.0	7.0	2.0	40	0.75	6.0	1.0	5.0	7
<b>2N5461</b>	1.5	1.0	75	1.0	7.0	2.0	40	1.0	7.5	2.0	9.0	7
<b>2N5462</b>	2.0	1.0	75	1.0	7.0	2.0	40	1.8	9.0	4.0	16	7

**Table 31. JFET High-Frequency Amplifiers**

The following is a listing of small-signal JFETs that are intended for hi-frequency applications. These are candidates for VHF/UHF oscillators, mixers and front-end amplifiers.

Device	$R_e  Y_{fs}  @ f$		$R_e  Y_{os}  @ f$		$C_{iss}$ pF Max	$C_{rss}$ pF Max	$NF @ R_G = 1K$		$V_{(BR)GSS}$ $V_{(BR)GDO}$ Volts Min	$V_{GS(off)}$ Volts		$I_{DSS}$ mA		Style
	mmho Min	MHz	$\mu$ mho Max	MHz			dB Max	f MHz		Min	Max	Min	Max	

**Case 29-04 — TO-226AA (TO-92) — N-Channel**

MPF102	1.6	100	200	100	7.0	3.0	—	—	25	—	8.0	2.0	20	5
2N5668	1.0	100	50	100	7.0	3.0	2.5	100	25	0.2	4.0	1.0	5.0	5
<b>2N5484</b>	2.5	100	75	100	5.0	1.0	3.0	100	25	0.3	3.0	1.0	5.0	5
<b>2N5485</b>	3.0	400	100	400	5.0	1.0	4.0	400	25	0.5	4.0	4.0	10	5
<b>2N5486</b>	3.5	400	100	400	5.0	1.0	4.0	400	25	2.0	6.0	8.0	20	5
<b>J308</b>	12 <sup>(1)</sup>	100	250 <sup>(1)</sup>	100	7.5	2.5	1.5 <sup>(1)</sup>	100	25	1.0	6.5	12	60	5
<b>J309</b>	12 <sup>(1)</sup>	100	250 <sup>(1)</sup>	100	7.5	2.5	1.5 <sup>(1)</sup>	100	25	1.0	4.0	12	30	5
<b>J310</b>	12 <sup>(1)</sup>	100	250 <sup>(1)</sup>	100	7.5	2.5	1.5 <sup>(1)</sup>	100	25	2.0	6.5	24	60	5

(1) Typical

Devices listed in bold, italic are Motorola preferred devices.

## JFETs (continued)

**Table 32. JFET Switches and Choppers**

The following is a listing of JFETs intended for switching and chopper applications.

Device	R <sub>DS(on)</sub> @ I <sub>D</sub>		V <sub>GS(off)</sub> Volts		I <sub>DSS</sub> mA		V <sub>(BR)GSS</sub> V <sub>(BR)GDO</sub> Volts	C <sub>iss</sub> pF	C <sub>rss</sub> pF	t <sub>on</sub> ns	t <sub>off</sub> ns	Style
	Ω Max	mA	Min	Max	Min	Max	Min	Max	Max	Max	Max	
<b>Case 29-04 — TO-226AA (TO-92) — N-Channel</b>												
<i>MPF4856</i>	25	—	4.0	10	50	—	40	18	8.0	9.0	25	5
<i>MPF4859</i>	25	—	4.0	10	50	—	30	18	8.0	9.0	25	5
J111	30	—	3.0	10	20	—	35	28	5.0	—	—	5
<i>MPF4857</i>	40	—	2.0	6.0	20	100	40	18	8.0	10	50	5
<i>MPF4860</i>	40	—	2.0	6.0	20	100	30	18	8.0	10	50	5
J112	50	—	1.0	5.0	5.0	—	35	28	5.0	—	—	5
<i>MPF4392</i>	60	—	—	—	25	75	30	10	3.5	15	35	5
2N5639	60	1.0	—	(8.0) <sup>(1)</sup>	25	—	30	10	4.0	—	—	5
<i>MPF4861</i>	60	—	0.8	4.0	8.0	80	30	18	8.0	20	100	5
<i>MPF4393</i>	100	—	—	(12) <sup>(1)</sup>	5.0	30	30	10	3.5	15	55	5
2N5640	100	1.0	—	(6.0) <sup>(1)</sup>	5.0	—	30	10	4.0	18	45	5
J113	100	—	0.5	3.0	2.0	—	35	28	5.0	—	—	5
2N5555	150	—	—	1.0 <sup>(16)</sup>	15	—	25	5.0	1.2	10	25	5
BF246A	35 <sup>(1)</sup>	1.0	0.6	14	30	80	25	—	—	—	—	22
BF246B	50 <sup>(1)</sup>	1.0	0.6	14	60	140	25	—	—	—	—	22
J110	18	—	0.5	4.0	10	—	25	—	—	—	—	5
<b>Case 29-04 — TO-226AA (TO-92) — P-Channel</b>												
MPF970	100	1.0	5.0	12	15	100	30	12	5.0	8.0	25	5
MPF971	250	1.0	1.0	7.0	2.0	50	30	12	5.0	10	120	5

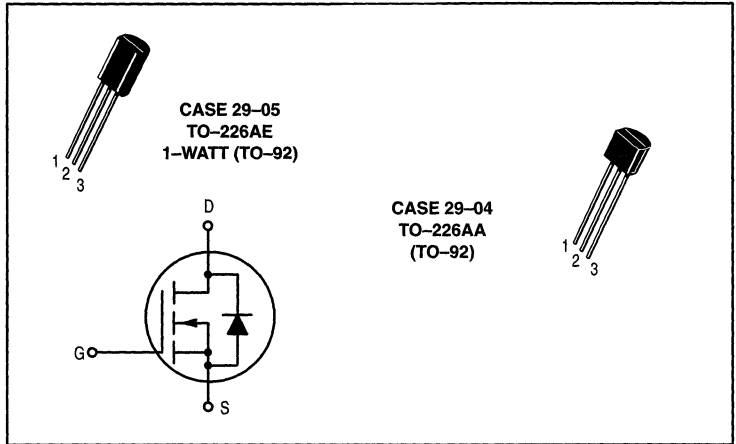
(1) Typical

(16) V<sub>GS(f)</sub>

Devices listed in bold, italic are Motorola preferred devices.



## TMOS FETs



**Table 33. TMOS Switches and Choppers**

The following is a listing of small-signal TMOS devices that are intended for switching and chopper applications. These devices offer low  $R_{DS(on)}$  characteristics.

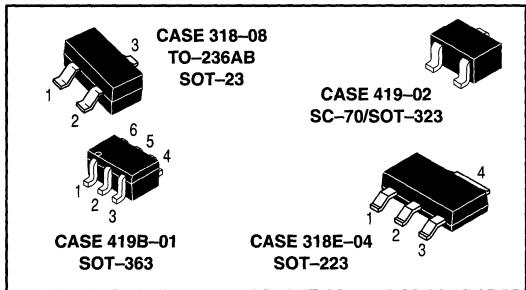
Device	$R_{DS(on)}$ @ $I_D$		$V_{GS(th)}$ Volts		$V_{(BR)DSS}$ Volts Min	$C_{iss}$ pF Max	$C_{rss}$ pF Max	$t_{on}$ ns Max	$t_{off}$ ns Max	Style
	$\Omega$ Max	A	Min	Max						
<b>Case 29-05 — TO-226AE (1-WATT TO-92) — N-Channel</b>										
<i>MPF930</i>	1.4	1.0	1.0	3.5	35	70(1)	20(1)	15	15	22
<i>MPF960</i>	1.7	1.0	1.0	3.5	60	70(1)	20(1)	15	15	22
MPF6659	1.8	1.0	0.8	2.0	35	30(1)	4(1)	5.0	5.0	22
<i>MPF990</i>	2.0	1.0	1.0	3.5	90	70(1)	20(1)	15	15	22
<i>MPF6660</i>	3.0	1.0	0.8	2.0	60	30(1)	4(1)	5.0	5.0	22
<i>MPF6661</i>	4.0	1.0	0.8	2.0	90	30(1)	4(1)	5.0	5.0	22
MPF910	5.0	0.5	0.3	2.5	60	—	—	—	—	22
VN10LM	5.0	0.5	0.8	2.5	60	60	5.0	10	10	22
<b>Case 29-04 — TO-226AA (TO-92) — N-Channel</b>										
<i>VN0300L</i>	1.2	1.0	0.8	2.5	60	100	25	30	30	22
<i>2N7000</i>	5.0	0.5	0.8	3.0	60	60	5.0	10	10	22
<i>BS170</i>	5.0	0.2	0.8	3.0	60	25(1)	3.0(1)	10	10	30
<i>VN0610LL</i>	5.0	0.5	0.8	2.5	60	60	5.0	10	10	22
<i>VN1706L</i>	6.0	0.5	0.8	2.0	170	125	20	8.0	18	22
<i>VN2406L</i>	6.0	0.5	0.8	2.0	240	125	20	8.0	23	22
BSS89	6.0	0.30	1.0	2.7	200	72(1)	3.0(1)	6.0(1)	12(1)	7
<i>BS107A</i>	6.4	0.25	1.0	3.0	200	60(1)	6.0(1)	15	15	30
<i>2N7008</i>	7.5	0.5	1.0	2.5	60	50	5.0	20	20	22
<i>VN2222LL</i>	7.5	0.5	0.6	2.5	60	60	5.0	10	10	22
<i>VN2410L</i>	10	0.5	0.8	2.0	240	125	20	8.0	23	22
BS107	14	0.2	1.0	3.0	200	60(1)	6.0(1)	15	15	30

(1) Typical

Devices listed in bold, italic are Motorola preferred devices.

# Surface Mount FETs

This section contains the FET plastic packages available for surface mount applications. Most of these devices are the most popular metal-can and insertion type parts carried over to the new surface mount packages.



**Table 34. Surface Mount RF JFETs**

The following is a list of surface mount FETs which are intended for VHF/UHF RF amplifier applications.

**Pinout: 1—Drain, 2—Source, 3—Gate**

Device	Marking	NF		Y <sub>fs</sub> @ V <sub>DS</sub>			V <sub>(BR)GSS</sub>	Style
		dB Typ	f MHz	mmhos Min	mmhos Max	Volts		
<b>Case 318-08 — TO-236AB (SOT-23) — N-Channel</b>								
<i>MMBFJ309LT1</i>	6U	1.5	450	10	20	10	25	10
<i>MMBFJ310LT1</i>	6T	1.5	450	8.0	18	10	25	10
<i>MMBFU310LT1</i>	M6C	1.5	450	10	18	10	25	10
<i>MMBF4416LT1</i>	M6A	2(3)	100	4.5	7.5	15	30	10
<i>MMBF5484LT1</i>	M6B	2.0	100	3.0	6.0	15	25	10
<i>MMBF5486LT1</i>	6H	2.0	100	4.0	8.0	15	25	10

**Case 419B-01 — SOT-363— Dual N-Channel**

<i>MBF4416DW1T1</i>	M6	2.0	100	4.5	7.5	15	30	7
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(3) Max

**Table 35. Surface Mount General-Purpose JFETs**

The following table is a listing of surface mount small-signal general purpose FETs. These devices are intended for small-signal amplification for DC, audio, and lower RF frequencies. They also have applications as oscillators and general-purpose, low-voltage switches.

**Pinout: 1—Drain, 2—Source, 3—Gate**

Device	Marking	V <sub>(BR)GSS</sub>	Y <sub>fs</sub> @ V <sub>DS</sub>			I <sub>DSS</sub>		Style
			mmhos Min	mmhos Max	Volts	mA Min	mA Max	
<b>Case 318-08 — TO-236AB (SOT-23) — N-Channel</b>								
<i>MMBF5457LT1</i>	6D	25	1.0	5.0	15	1.0	5.0	10
<i>MMBF5459LT1</i>	6L	25	2.0	6.0	15	4.0	16	10
<b>Case 318-08 — TO-236AB (SOT-23) — P-Channel</b>								
<i>MMBF5460LT1</i>	M6E	40	1.0	4.0	15	1.0	5.0	10
<b>Case 419B-01 — SOT-363 — Dual N-Channel</b>								
<i>MBF5457DW1T1</i>	6D	25	1.0	5.0	15	1.0	5.0	7

(3) Max

Devices listed in bold, italic are Motorola preferred devices.

## Surface Mount FETs (continued)

**Table 36. Surface Mount Choppers/Switches JFETs**

The following is a listing of small-signal surface mount JFET devices intended for switching and chopper applications.

Pinout: 1–Drain, 2–Source, 3–Gate

Device	Marking	R <sub>DS(on)</sub> Ohms Max	t <sub>off</sub> ns Max	V <sub>(BR)GSS</sub>	V <sub>GS(off)</sub>		I <sub>DSS</sub>		Style
					Volts Min	Volts Max	mA Min	mA Max	
<b>Case 318–08 — TO–236AB (SOT–23) — N–Channel</b>									
<i>MMBF4856LT1</i>	AAA	25	25	40	–4.0	–10	50	—	10
<i>MMBF4391LT1</i>	6J	30	20	30	–4.0	–10	50	150	10
<i>MMBF4860LT1</i>	6F	40	50	30	–2.0	–6.0	20	100	10
<i>MMBF4392LT1</i>	6K	60	35	30	–2.0	–5.0	25	75	10
<i>MMBF4393LT1</i>	6G	100	50	30	–0.5	–3.0	5.0	30	10
<b>Case 318–08 — TO–236AB (SOT–23) — P–Channel</b>									
<i>MMBFJ175LT1</i>	6W	125	—	30	3.0	6.0	7.0	60	10
<i>MMBFJ177LT1</i>	6Y	300	—	30	0.8	2.5	1.5	20	10

**Table 37. TMOS FETs**

The following is a listing of small-signal surface mount TMOS FETs which exhibit low R<sub>DS(on)</sub> characteristics.

Pinout: 1–Gate, 2–Source, 3–Drain

Device	Marking	R <sub>DS(on)</sub> @ I <sub>D</sub>		V <sub>DSS</sub>	V <sub>GS(th)</sub>		Switching Time		Style
		Ohm	mA		Volts Min	Volts Max	t <sub>on</sub> ns	t <sub>off</sub> ns	
<b>Case 318–08 — TO–236AB (SOT–23) — N–Channel</b>									
<i>MMBF170LT1</i>	6Z	5.0	200	60	0.8	3.0	10	10	21
<i>BSS123LT1</i>	SA	6.0	100	100	0.8	2.8	20	40	21
<i>BSS138LT1</i>	J1	3.5	200	50	0.5	1.5	20	20	21
<i>2N7002LT1</i>	702	7.5	500	60	1.0	2.5	20	20	21
<i>MMBF0201NLT1</i>	N1	1.0	300	20	1.0	2.4	2.5	15	21
<i>MGSF1N02LT1</i>	N2	0.085	1200	20	1.0	2.4	2.5	16	21
<i>MGSF1N03LT1</i>	N3	0.09	1200	30	1.0	2.4	2.5	16	21
<b>Case 318–08 — TO–236 (SOT–23) — P–Channel</b>									
<i>BSS84LT1</i>	PD	6.0	100	50	1.0	2.4	2.5	16	21
<i>MMBF0202PLT1</i>	P3	1.4	200	20	1.0	2.0	2.5	16	21
<i>MGSF1P02LT1</i>	PC	0.35	1500	20	1.0	2.4	2.5	16	21
<i>MGSF1P02ELT1</i>	PE	0.16	1500	20	0.7	1.0	2.5	16	21
<b>Pinout: 1–Gate, 2–Drain, 3–Source, 4–Drain</b>									
Device	Marking	R <sub>DS(on)</sub>		V <sub>DSS</sub>	V <sub>GS(th)</sub>		Switching Time		Style
		Ohm	mA		Volts Min	Volts Max	t <sub>on</sub> ns	t <sub>off</sub> ns	
<b>Case 318E–04— SOT–223 — N–Channel</b>									
<i>MMFT960T1</i>	FT960	1.7	1000	60	1.0	3.5	15	15	3
<i>MMFT6661T1</i>	T6661	4.0	1000	90	0.8	2.0	5.0	5.0	3
<i>MMFT2406T1</i>	T2406	10	200	240	0.8	2.0	—	—	3
<i>MMFT107T1</i>	FT107	14	200	200	1.0	3.0	15	15	3
<b>Case 419–02 — SC–70/SOT–323 — N–Channel</b>									
<i>MMBF2201NT1</i>	N1	1.0	300	20	1.0	2.4	2.5	15	8
<b>Case 419–02 — SC–70/SOT–323 — P–Channel</b>									
<i>MMBF2202PT1</i>	P3	2.2	200	20	1.0	2.4	2.5	16	8

Devices listed in bold, italic are Motorola preferred devices.



# Tuning and Switching Diodes

## Tuning Diodes — Abrupt Junction

Motorola supplies voltage-variable capacitance diodes serving the entire range of frequencies from HF through UHF. Used in RF receivers and transmitters, they have a variety of applications, including:

- Phase-locked loop tuning systems
- Local oscillator tuning
- Tuned RF preselectors
- RF filters
- RF phase shifters
- RF amplifiers
- Automatic frequency control
- Video filters and delay lines
- Harmonic generators
- FM modulators

Two families of devices are available: Abrupt Junction and Hyper Abrupt Junction. The Abrupt Junction family includes devices suitable for virtually all tuned-circuit and narrow-range tuning applications throughout the spectrum.

**CASE 29-04**  
TO-226AA (TO-92)

**CASE 51-02**  
DO-204AA (DO-7)

**CASE 182-02**  
TO-226AC (TO-92)

**CASE 318-08**  
TO-236AB SOT-23

**CASE 463-01**  
SOT-416/SC-90

STYLE 15

STYLE 1

STYLE 1

Cathode Anode

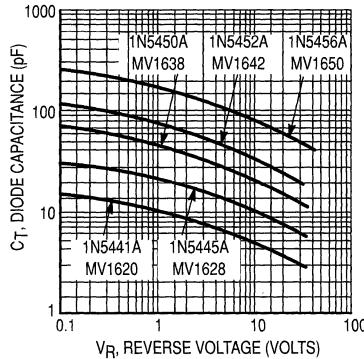
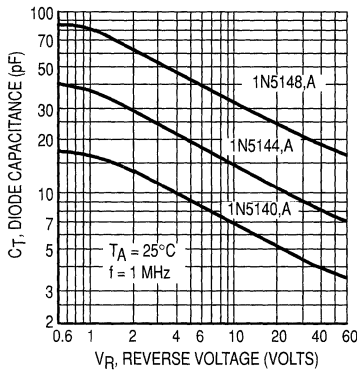
STYLE 8

Cathode Anode

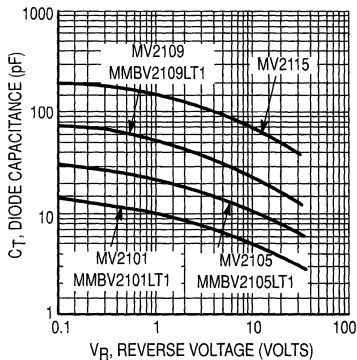
STYLE 9

## Typical Characteristics

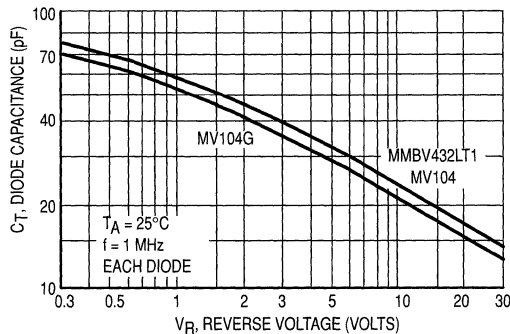
### Diode Capacitance versus Reverse Voltage



(See Tables 38 Thru 40)



(See Tables 41 and 42)



(See Table 43)

## Tuning Diodes — Abrupt Junction (continued)

**Table 38. General-Purpose Glass Abrupt Tuning Diodes  
High Q Capacitance Ratio @ 4.0 Volts/60 Volts**

The following is a listing of axial leaded, general-purpose, abrupt tuning diodes. These devices exhibit high Q characteristics.

Device <sup>(19)</sup>	C <sub>T</sub> @ V <sub>R</sub> = 4.0 V, 1.0 MHz			V <sub>R(BR)R</sub> Volts	Cap Ratio C <sub>4</sub> /C <sub>60</sub> Min	Q 4.0 V, 50 MHz Min
	pF Min	pF Nominal	pF Max			

**Case 51-02 — DO-204AA (DO-7)**

1N5139	6.1	6.8	7.5	60	2.7	350
1N5140	9.0	10	11	60	2.8	300
1N5143	16.2	18	19.8	60	2.8	250
1N5144	19.8	22	24.2	60	3.2	200
1N5145	24.3	27	29.7	60	3.2	200
1N5148	42.3	47	51.7	60	3.2	200

**Table 39. General-Purpose Glass Abrupt Tuning Diodes  
High Q Capacitance Ratio @ 2.0 Volts/30 Volts**

The following is a listing of axial leaded, general-purpose, abrupt tuning diodes. These devices exhibit very high Q characteristics.

Device <sup>(20)</sup>	C <sub>T</sub> @ V <sub>R</sub> = 4.0 V, 1.0 MHz			V <sub>R(BR)R</sub> Volts	Cap Ratio C <sub>2</sub> /C <sub>30</sub> Min	Q 4.0 V, 50 MHz Min
	pF Min	pF Nominal	pF Max			

**Case 51-02 — DO-204AA (DO-7)**

1N5441A	6.1	6.8	7.5	30	2.5	450
1N5444A	10.8	12	13.2	30	2.6	400
1N5446A	16.2	18	19.8	30	2.6	350
1N5448A	19.8	22	24.2	30	2.6	350
1N5449A	24.3	27	29.7	30	2.6	350
1N5450A	29.7	33	36.3	30	2.6	350
1N5451A	35.1	39	42.9	30	2.6	300
1N5452A	42.3	47	51.7	30	2.6	250
1N5453A	50.4	56	61.6	30	2.6	200
1N5455A	73.8	82	90.2	30	2.7	175
1N5456A	90	100	110	30	2.7	175

<sup>(19)</sup>Suffix A = 10.0%

<sup>(20)</sup>Suffix B = 5.0%

## Tuning Diodes — Abrupt Junction (continued)

**Table 40. General-Purpose Glass Abrupt Tuning Diodes**  
Capacitance Ratio @ 2.0 Volts/20 Volts

The following is a listing of axial leaded, general-purpose, abrupt tuning diodes. These devices exhibit high Q characteristics.

Device	$C_T @ V_R = 4.0 \text{ V}, 1.0 \text{ MHz}$			$V_{R(BR)R}$ Volts	Cap Ratio C2/C20 Min	Q 4.0 V, 50 MHz Typ
	pF Min	pF Nominal	pF Max			

### Case 51-02 — DO-204AA (DO-7)

MV1620	6.1	6.8	7.5	20	2.0	300
MV1624	9.0	10	11	20	2.0	300
MV1626	10.8	12	13.2	20	2.0	300
MV1628	13.5	15	16.5	20	2.0	250
MV1630	16.2	18	19.8	20	2.0	250
MV1634	19.8	22	24.2	20	2.0	250
MV1636	24.3	27	29.7	20	2.0	200
MV1638	29.7	33	36.3	20	2.0	200
MV1640	35.1	39	42.9	20	2.0	200
MV1642	42.3	47	51.7	20	2.0	200
MV1644	50.4	56	61.6	20	2.0	150
MV1648	73.8	82	90.2	20	2.0	150
MV1650	90	100	110	20	2.0	150

**Table 41. General-Purpose Plastic Abrupt Tuning Diodes**  
Capacitance Ratio @ 2.0 Volts/30 Volts

The following is a listing of plastic package, general-purpose, abrupt tuning diodes. These devices exhibit high Q characteristics.

Device	$C_T @ V_R = 4.0 \text{ V}, 1.0 \text{ MHz}$			$V_{R(BR)R}$ Volts	Cap Ratio C4/C30 Min	Q 4.0 V, 50 MHz Typ
	pF Min	pF Nominal	pF Max			

### Case 182-02 — TO-226AC (TO-92) — 2-Lead

<b><i>MV2101</i></b>	6.1	6.8	7.5	30	2.5	400
MV2103	9.0	10	11	30	2.5	350
<b><i>MV2104</i></b>	10.8	12	13.2	30	2.5	350
MV2105	13.5	15	16.5	30	2.5	350
MV2107	19.8	22	24.2	30	2.5	300
<b><i>MV2108</i></b>	24.3	27	29.7	30	2.5	250
<b><i>MV2109</i></b>	29.7	33	36.3	30	2.5	200
<b><i>MV2111</i></b>	42.3	47	51.7	30	2.5	150
<b><i>MV2113</i></b>	61.2	68	74.8	30	2.5	150
MV2114	73.8	82	90.2	30	2.5	100
<b><i>MV2115</i></b>	90	100	110	30	2.6	100

Devices listed in bold, italic are Motorola preferred devices.

## Tuning Diodes — Abrupt Junction (continued)

**Table 42. Surface Mount Abrupt Tuning Diodes  
Capacitance Ratio @ 2.0 Volts/30 Volts**

The following is a listing of surface mount abrupt junction tuning diodes intended for general-purpose variable capacitance circuit applications.

Device	C <sub>T</sub> @ V <sub>R</sub> = 4.0 V, 1.0 MHz			V <sub>R(BR)R</sub> Volts	Cap Ratio C <sub>2</sub> /C <sub>30</sub> Min	Q 4.0 V, 50 MHz Typ
	pF Min	pF Nominal	pF Max			
<b>Case 318-08 — DO-236AB (SOT-23)</b>						
<b><i>MMBV2101LT1</i></b>	6.1	6.8	7.5	30	2.5	400
MMBV2103LT1	9.0	10	11	30	2.5	350
MMBV2104LT1	10.8	12	13.2	30	2.5	350
<b><i>MMBV2105LT1</i></b>	13.5	15	16.5	30	2.5	350
MMBV2107LT1	19.8	22	24.2	30	2.5	300
MMBV2108LT1	24.3	27	29.7	30	2.5	250
<b><i>MMBV2109LT1</i></b>	29.7	33	36.3	30	2.5	200

**Table 43. Abrupt Tuning Diodes for FM Radio — Dual**

The following is a listing of abrupt tuning diodes that are available as dual units in a single package.

Device	C <sub>T</sub> @ V <sub>R</sub> ( <sup>22</sup> )			Cap Ratio C <sub>3</sub> /C <sub>30</sub> Min	Q 3.0 V, 50 MHz Min	V <sub>R(BR)R</sub> Volts	Device Marking	Style
	pF Min	pF Max	Volts					
<b>Case 29-04 — TO-226AA (TO-92)</b>								
<b><i>MV104</i></b>	37	42	3.0	2.5	100	32	—	15
<b>Case 318-08 — TO-236AB (SOT-23)</b>								
<b><i>MMBV432LT1</i></b>	43	48.1	2.0	1.5( <sup>21</sup> )	100	14	M4B	9

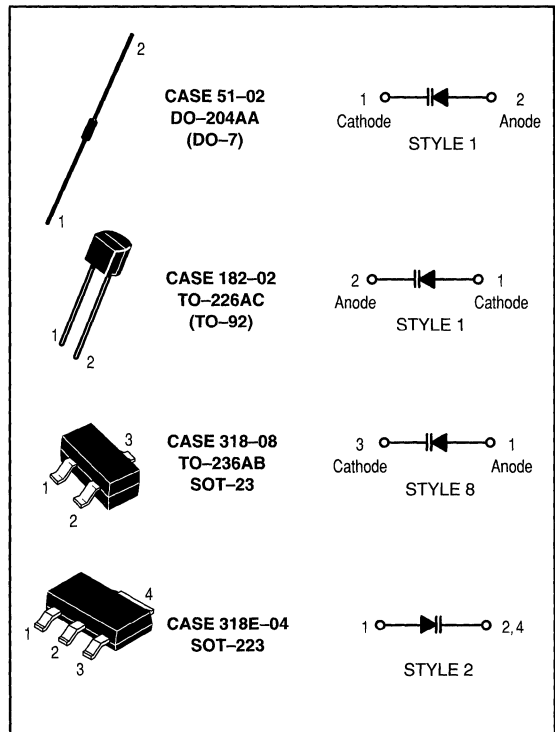
(<sup>21</sup>)C<sub>2</sub>/C<sub>8</sub>

(<sup>22</sup>)Each Diode

Devices listed in bold, italic are Motorola preferred devices.

# Tuning Diodes — Hyper-Abrupt Junction

The Hyper-Abrupt family exhibits higher capacitance, and a much larger capacitance ratio. It is particularly well suited for wider-range applications such as AM/FM radio and TV tuning.



## Typical Characteristics

### Diode Capacitance versus Reverse Voltage

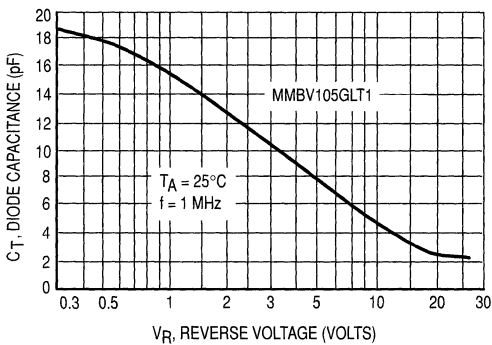


Figure 1. Diode Capacitance

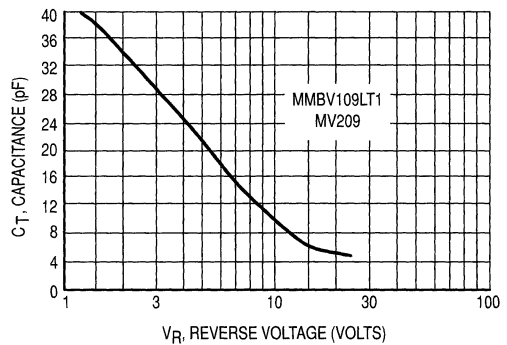


Figure 2. Diode Capacitance

## Tuning Diodes — Hyper-Abrupt Junction (continued)

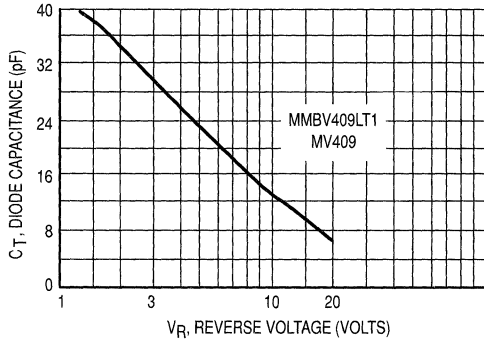


Figure 3. Diode Capacitance

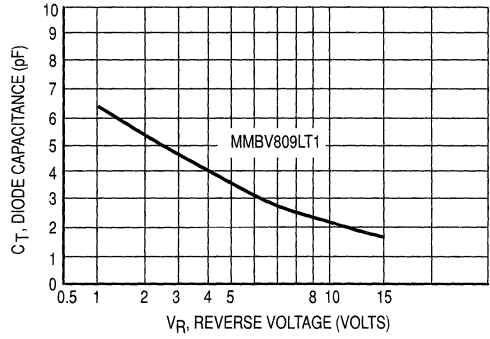


Figure 4. Diode Capacitance

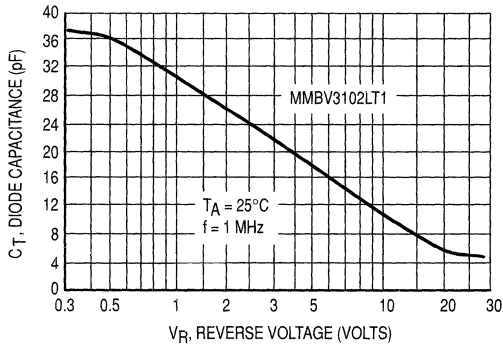


Figure 5. Diode Capacitance

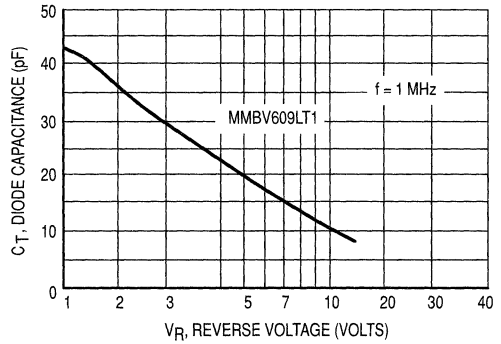


Figure 6. Diode Capacitance Each Die

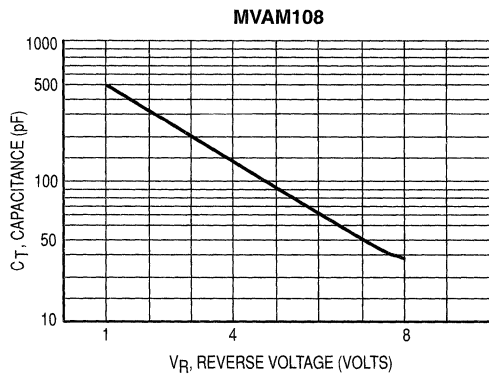


Figure 7. Capacitance versus Reverse Voltage

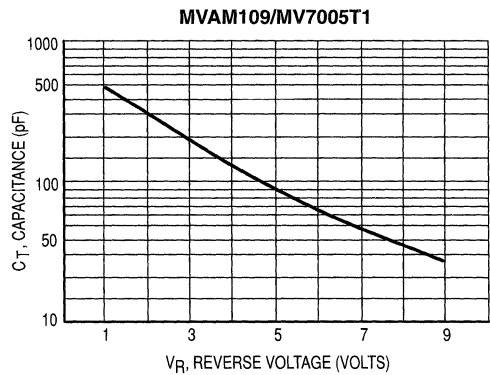


Figure 8. Capacitance versus Reverse Voltage

## Tuning Diodes — Hyper-Abrupt Junction (continued)

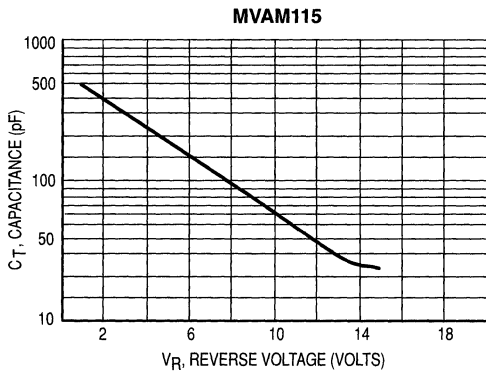


Figure 9. Capacitance versus Reverse Voltage

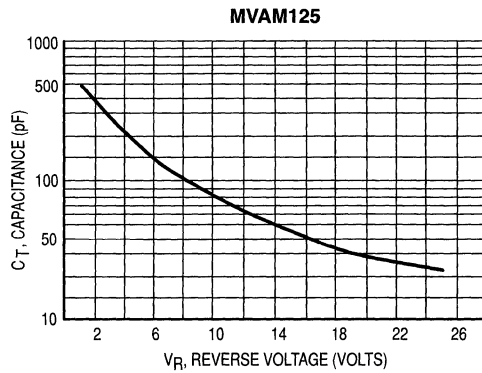


Figure 10. Capacitance versus Reverse Voltage

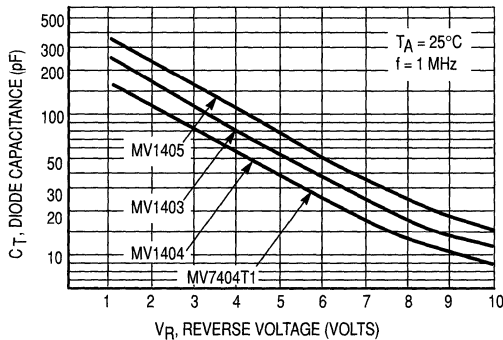


Figure 11. Diode Capacitance versus Reverse Voltage

Table 44. Hyper-Abrupt Tuning Diodes for Telecommunications — Single

The following is a listing of hyper-abrupt tuning diodes intended for high frequency, FM radio, and TV tuner applications.

Device	$C_T$ @ $V_R$ ( $f = 1.0$ MHz)			Cap Ratio @ $V_R$			Q		$V_{(BR)R}$ Volts	Device Marking	Case Style	CV Curve Fig
	pF Min	pF Max	Volts	Min	Max	Volts	3.0 V Min	50 MHz Max				
<b>Case 182-02 — TO-226AC (TO-92)</b>												
<i>MV209</i>	26	32	3.0	5.0	6.5	3/25	200	—	30	—	1	2
<i>MV409</i>	26	32	3.0	1.5	2.0	3/8	200	—	20	—	1	3
<b>Case 318-08 — TO-236AB (SOT-23)</b>												
<i>MMBV105GLT1</i>	1.5	2.8	2.5	4.0	6.5	3/25	200	—	30	M4E	8	1
<i>MMBV109LT1</i>	26	32	3.0	5.0	6.5	3/25	200	—	30	M4A	8	2
<i>MMBV409LT1</i>	26	32	3.0	1.5	1.9	3/8	200	—	20	X5	8	3
<i>MMBV809LT1</i>	4.5	6.1	2.0	1.8	2.6	2/8	300	—	20	5K	8	4
<i>MMBV3102LT1</i>	20	25	3.0	4.5	—	3/25	200	—	30	M4C	8	5
<b>Case 419-02 — SC-70/SOT-323</b>												
<i>MBV109T1</i>	26	32	3.0	5.0	6.5	3/25	200	—	30	M4A	8	—

Devices listed in bold, italic are Motorola preferred devices.

## Tuning Diodes — Hyper-Abrupt Junction (continued)

**Table 45. Hyper-Abrupt Tuning Diodes for Communications — Dual**

Device	$C_T @ V_R (f = 1.0 \text{ MHz})$			Cap Ratio @ $V_R$			Q		$V_{(BR)R}$ Volts	Device Marking	Case Style	CV Curve Fig
	pF Min	pF Max	Volts	Min	Max	Volts	3.0 V Min	50 MHz Max				

**Case 318-08 — TO-236AB (SOT-23)**

<b><i>MMBV609LT1</i></b>	26	32	3.0	1.8	2.4	3/8	250	—	20	5L	9	6
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**Table 46. Hyper-Abrupt Tuning Diodes for Low Frequency Applications — Single**

The following is a listing of AM, hyper-abrupt tuning diodes that have a large capacity range and are designed for low frequency circuit applications.

Device	$C_T @ 1.0 \text{ MHz}$			Cap Ratio @ $V_R$		$V_{(BR)R}$ Volts	Style	CV Curve Figure
	pF Min	pF Max	Volts	Min	Volts			

**Case 182-02— TO-226AC (TO-92)**

<b><i>MVAM108</i></b>	440	560	1.0	15	1.0/8.0	12	1	7
<b><i>MVAM109</i></b>	400	520	1.0	12	1.0/9.0	15	1	8
<b><i>MVAM115</i></b>	440	560	1.0	15	1.0/15	18	1	9
<b><i>MVAM125</i></b>	440	560	1.0	15	1.0/25	28	1	10

**Table 47. Hyper-Abrupt High Capacitance Voltage Variable Diode — Surface Mount**

The following are high capacitance voltage variable diodes intended for low frequency applications and circuits requiring large tuning capacitance.

Device	$V_{(BR)R}$ Volts	$I_R$ nA	$C_T @ f = 1.0 \text{ MHz}$		Cap Ratio Min	Q Min	Style	CV Curve Figure
			Min pF	Max pF				

**Case 318E-04— SOT-223**

**Pinout: 1—Anode, 2, 4—Cathode, 3—NC**

<b><i>MV7005T1</i></b>	15	100	400	520	12 <sup>(26)</sup>	150 <sup>(28)</sup>	2	8
<b><i>MV7404T1</i></b>	12	100	96	144	10 <sup>(27)</sup>	200 <sup>(29)</sup>	2	11

**Table 48. Hyper-Abrupt High Capacitance Tuning Diodes — Axial Lead Glass Package**

Device	$C_T @ V_R$			Cap Ratio C2/C10 Min	Q 2.0 V, 1.0 MHz Min	$V_{(BR)R}$ Volts	Style	CV Curve Figure
	pF Min	pF Max	Volts					

**Case 51-02 — DO-204AA (DO-7)**

<b><i>MV1404</i></b>	96	144	2.0	10	200	12	1	11
<b><i>MV1403</i></b>	140	210	2.0	10	200	12	1	11
<b><i>MV1405</i></b>	200	300	2.0	10	200	12	1	11

<sup>(26)</sup>  $V_R = 1.0 \text{ V}$ ,  $V_{BR} = 9.0 \text{ V}$

<sup>(27)</sup>  $V_R = 2.0 \text{ V}$ ,  $V_{BR} = 10 \text{ V}$

<sup>(28)</sup>  $V_R = 1.0 \text{ V}$ ,  $f = 1.0 \text{ MHz}$

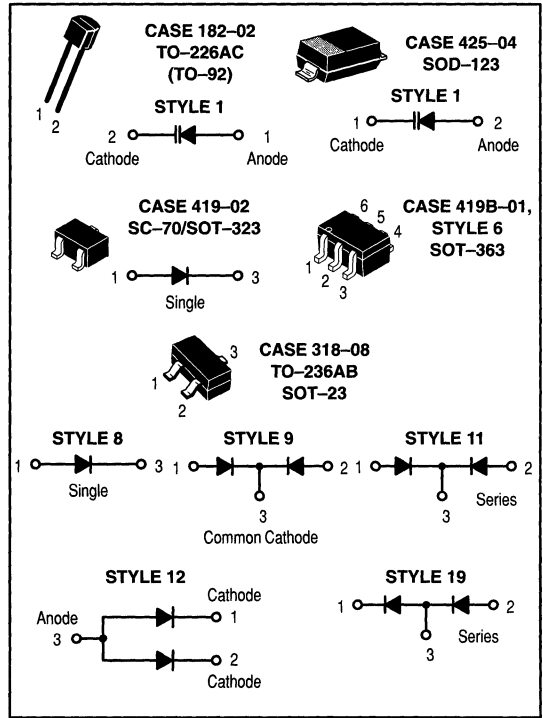
<sup>(29)</sup>  $V_R = 2.0 \text{ V}$ ,  $f = 1.0 \text{ MHz}$

Devices listed in bold, italic are Motorola preferred devices.



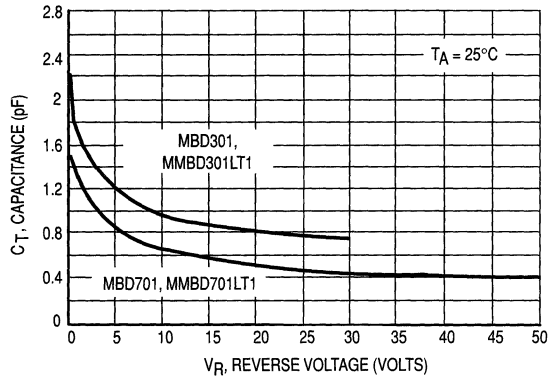
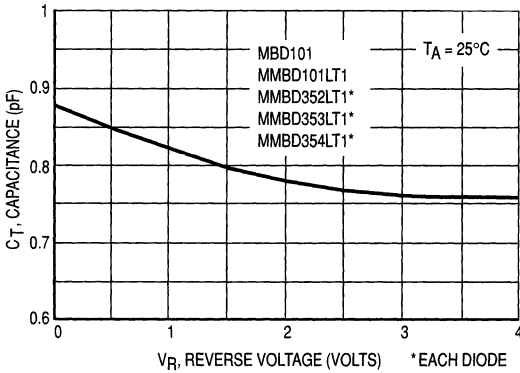
# Schottky Diodes

Schottky diodes are ideal for VHF and UHF mixer and detector applications as well as many higher frequency applications. They provide stable electrical characteristics by eliminating the point-contact diode presently used in many applications.



## Typical Characteristics

### Capacitance versus Reverse Voltage



(See Table 49)

Devices listed in bold, italic are Motorola preferred devices.

## Schottky Diodes (continued)

**Table 49. Schottky Diodes**

The following is a listing of Schottky diodes that exhibit low forward voltage drop for improved circuit efficiency.

Device	V <sub>(BR)R</sub> Volts	C <sub>T</sub> @ V <sub>R</sub> pF Max	V <sub>F</sub> @ 10 mA Volts Max	I <sub>R</sub> @ V <sub>R</sub> nA Max	Minority Lifetime pS (TYP)	Device Marking	Style				
<b>Case 182-02 — TO-226AC (TO-92)</b>											
<i><b>MBD701</b></i>	70	1.0 @ 20 V	1.0	200 @ 35 V	15	—	1				
<i><b>MBD301</b></i>	30	1.5 @ 15 V	0.6	200 @ 25 V	15	—	1				
<i><b>MBD101</b></i>	7.0	1.0 @ 0 V	0.6	250 @ 3.0 V	—	—	1				
<b>Case 318-08 — TO-236AB (SOT-23)</b>											
<i><b>MMBD701LT1</b></i>	70	1.0 @ 20 V	1.0	200 @ 35 V	15	5H	8				
<i><b>MMBD301LT1</b></i>	30	1.5 @ 15 V	0.6	200 @ 25 V	15	4T	8				
<i><b>MMBD101LT1</b></i>	7.0	1.0 @ 0 V	0.6	250 @ 3.0 V	15	4M	8				
<i><b>MMBD352LT1</b></i> <sup>(23)</sup>	7.0	1.0 @ 0 V	0.6	250 @ 3.0 V	15	M5G	11				
<i><b>MMBD353LT1</b></i> <sup>(23)</sup>	7.0	1.0 @ 0 V	0.6	250 @ 3.0 V	15	M4F	19				
<i><b>MMBD354LT1</b></i> <sup>(23)</sup>	7.0	1.0 @ 0 V	0.6	250 @ 3.0 V	15	M6H	9				
<i><b>MMBD355LT1</b></i> <sup>(23)</sup>	7.0	1.0 @ 0 V	0.6	250 @ 3.0 V	15	MJ1	12				
<i><b>MMBD452LT1</b></i> <sup>(23)</sup>	30	1.5 @ 1.5 V	0.6	200 @ 25 V	15	5N	11				
<b>Case 425-04 — (SOD-123)</b>											
<i><b>MMSD701T1</b></i>	70	1.0 @ 20 V	1.2	0.2 @ 35 V	15	5H	1				
<i><b>MMSD301T1</b></i>	30	1.5 @ 15 V	0.6	0.2 @ 25 V	15	4T	1				
<i><b>MMSD101T1</b></i>	4	1.0 @ 0 V	0.6	0.25 @ 3 V	15	4M	1				
<b>Case 419-02 — (SC-70/SOT-323)</b>											
<i><b>MMBD330T1</b></i>	30	1.5 @ 15 V	0.6	0.2 @ 25 V	—	4T	2				
<i><b>MMBD770T1</b></i>	70	1.0 @ 20 V	1.0	0.2 @ 35 V	—	5H	2				
<sup>(23)</sup> Dual Diodes											
<b>Case 419B-01 — SOT-363 – Duals</b>											
Device	Marking	V <sub>(BR)R</sub>		I <sub>R</sub>		V <sub>F</sub>			C <sub>T</sub> (30) Max (pF)	t <sub>rr</sub> Max (ns)	Case Style
		Min Volts	@ I <sub>BR</sub> (μA)	Max (μA)	@ V <sub>R</sub> Volts	Min Volts	Max Volts	@ I <sub>F</sub> (mA)			
<i><b>MBD110DWT1</b></i>	M4	7	10	200	25	—	0.6	1.0	1.0	—	6
<i><b>MBD330DWT1</b></i>	T4	30	10	200	25	—	0.4	1.0	1.5	—	6
<i><b>MBD770DWT1</b></i>	H5	70	10	200	25	—	0.5	1.0	1.0	—	6

<sup>(30)</sup> V<sub>R</sub> = 0 V, f = 1.0 MHz

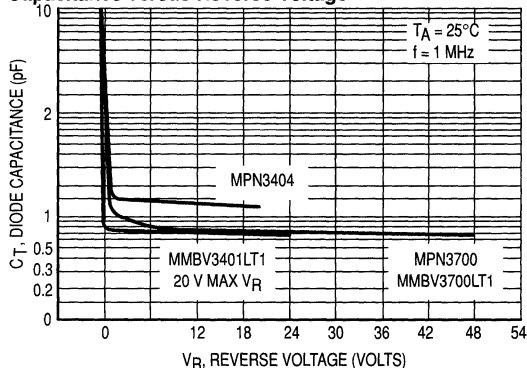
Devices listed in bold, italic are Motorola preferred devices.

# Switching Diodes

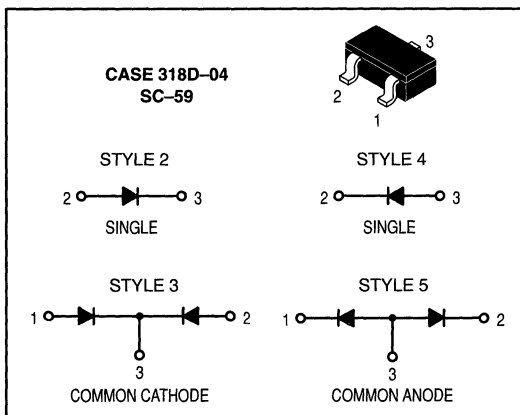
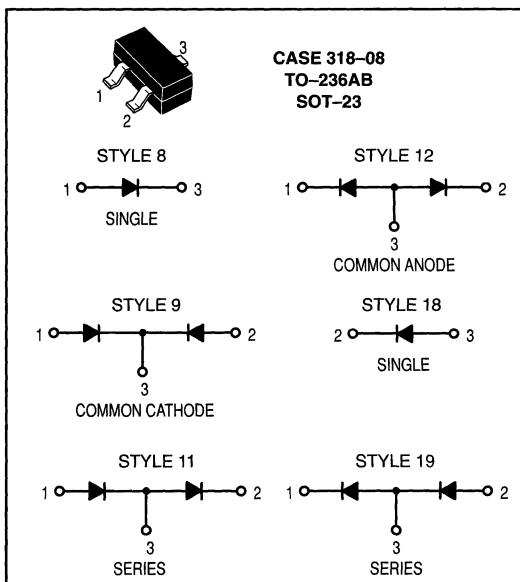
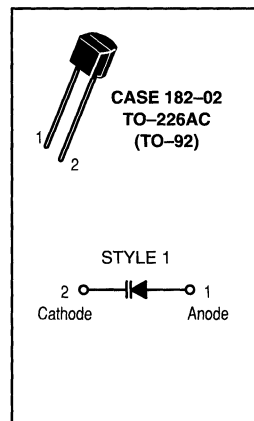
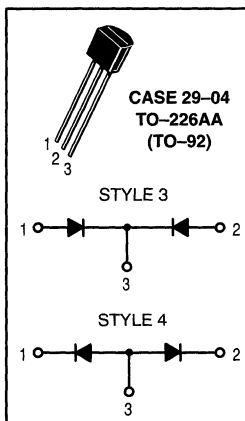
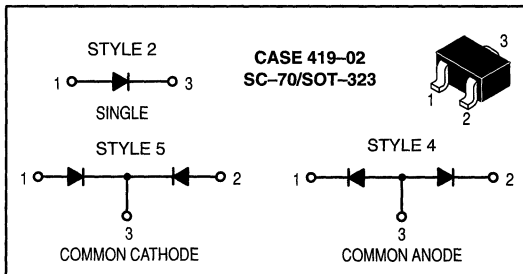
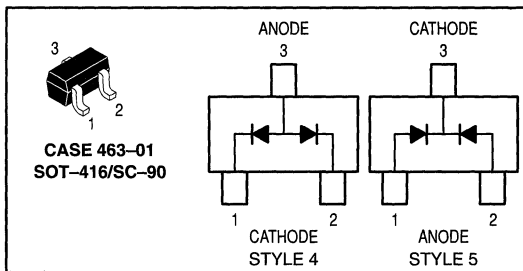
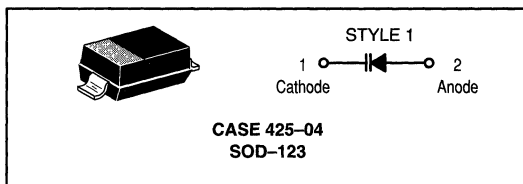
Small-signal switching diodes are intended for low current switching and steering applications. Hot-Carrier, PIN and general-purpose diodes allow a wide selection for specific application requirements.

## Typical Characteristics

### Capacitance versus Reverse Voltage



(See Table 50)



## Switching Diodes (continued)

**Table 50. PIN Switching Diodes**

The following PIN diodes are designed for VHF band switching and general-purpose low current switching applications.

Device	V <sub>(BR)R</sub> Volts Min	C <sub>T</sub> @ V <sub>R</sub> @ 1.0 MHz		I <sub>R</sub> @ V <sub>R</sub> μA Max	Series Resistance Ohm Max	Device Marking	Style
		pF Max	Volts				

**Case 182-02 — TO-226AC (TO-92)**

MPN3700	200	1.0	20	0.1 @ 150	1.0 @ 10 mA	—	1
<b>MPN3404</b>	20	2.0	15	0.1 @ 25 V	0.85 @ 10 mA	—	1

**Case 318-08 — TO-236AB (SOT-23)**

MMBV3700LT1	200	1.0	20	0.1 @ 150	1.0 @ 10 mA	4R	8
<b>MMBV3401LT1</b>	35	1.0	20	0.1 @ 25 V	0.7 @ 10 mA	4D	8

**Table 51. General-Purpose Signal and Switching Diodes — Single**

The following is a listing of small-signal switching diodes in surface mount packages. These diodes are intended for low current switching and signal steering applications.

Device	Marking	V <sub>(BR)R</sub>		I <sub>R</sub>		V <sub>F</sub>			C <sub>T</sub> (30)	t <sub>rr</sub>	Case Style
		Min Volts	@ I <sub>BR</sub> (μA)	Max (μA)	@ V <sub>R</sub> Volts	Min Volts	Max Volts	@ I <sub>F</sub> (mA)	Max (pF)	Max (ns)	

**Case 318-08 — TO-236AB (SOT-23)**

<b>BAS21LT1</b>	JS	250	100	0.1	200	—	1.0	100	5.0	50	8
<b>MMBD914LT1</b>	5D	100	100	5.0	75	—	1.0	10	4.0	4.0	8
<b>BAS16LT1</b>	A6	75	100	1.0	75	—	1.0	50	2.0	6.0	8
<b>MMBD6050LT1</b>	5A	70	100	0.1	50	0.85	1.1	100	2.5	4.0	8
<b>BAL99LT1</b>	JF	70	100	2.5	70	—	1.0	50	1.5	6.0	18

**Case 318D-04 — SC-59**

<b>M1MA151AT1</b>	MA	40	100	0.1	35	—	1.2	100	2.0	3.0	4
<b>M1MA151KT1</b>	MH	40	100	0.1	35	—	1.2	100	2.0	3.0	2

**Case 419-02 — SC-70/SOT-323**

<b>BAS16WT1</b>	A6	75	1.0	0.02	20	—	1.25	150	2.0	6.0	2
<b>M1MA141KT1</b>	MH	40	100	0.1	35	—	1.2	100	2.0	3.0	2
<b>M1MA142KT1</b>	MI	80	100	0.1	75	—	1.2	100	2.0	3.0	2
<b>M1MA174T1</b>	J6	100	100	5.0	75	—	1.0	10	4.0	4.0	2

**Case 425-04 — SOD-123**

<b>MMSD914T1</b>	5D	100	100	5.0	75	—	1.0	10	4.0	4.0	1
MMSD4148T1	5I	100	100	5.0	75	—	1.0	10	4.0	4.0	1
MMSD71RKT1	6S	—	—	0.5	80	—	1.2	100	2.0	4.0	1

(30) V<sub>R</sub> = 0 V, f = 1.0 MHz

Devices listed in bold, italic are Motorola preferred devices.

## Switching Diodes (continued)

**Table 52. General-Purpose Signal and Switching Diodes — Dual**

The following is a listing of small-signal switching diodes in surface mount packages. These diodes are intended for low current switching and signal steering applications.

Device	Marking	V(BR)R		I <sub>R</sub>		V <sub>F</sub>			C <sub>T</sub> (30)	t <sub>rr</sub>	Case Style
		Min Volts	@ I <sub>BR</sub> (μA)	Max (μA)	@ V <sub>R</sub> Volts	Min Volts	Max Volts	@ I <sub>F</sub> (mA)	Max (pF)	Max (ns)	
<b>Case 318-08 — TO-236AB (SOT-23)</b>											
<i>MMBD7000LT1</i>	M5C	100	100	1.0	50	0.75	1.1	100	1.5	4.0	11
MMBD2836LT1	A2	75	100	0.1	50	—	1.0	10	4.0	4.0	12
MMBD2838LT1	A6	75	100	0.1	50	—	1.0	10	4.0	4.0	9
<i>BAV70LT1</i>	A4	70	100	5.0	70	—	1.0	50	1.5	6.0	9
<i>BAV99LT1</i>	A7	70	100	2.5	70	—	1.0	50	1.5	4.0	11
<i>BAW56LT1</i>	A1	70	100	2.5	70	—	1.0	50	2.0	6.0	12
MMBD6100LT1	5BM	70	100	0.1	50	0.85	1.1	100	2.5	4.0	9
BAV74LT1	JA	50	5.0	0.1	50	—	1.0	100	2.0	4.0	9
MMBD2835LT1	A3	35	100	0.1	30	—	1.0	10	4.0	4.0	12
MMBD2837LT1	A5	35	100	0.1	30	—	1.0	10	4.0	4.0	9

**Case 318D-04 — SC-59**

<i>M1MA151WAT1</i>	MN	40	100	0.1	35	—	1.2	100	15	10	5
<i>M1MA151WKT1</i>	MT	40	100	0.1	35	—	1.2	100	2.0	3.0	3

**Case 419-02 — SC-70/SOT-323**

<i>M1MA142WKT1</i>	MU	80	100	0.1	75	—	1.2	100	2.0	3.0	5
<i>M1MA142WAT1</i>	MO	80	100	0.1	75	—	1.2	100	15	10	4
<i>BAW56WT1</i>	A1	70	100	2.5	70	—	1.0	50	2.0	6.0	4
<i>BAV70WT1</i>	A4	70	100	5.0	70	—	1.0	50	1.5	6.0	5
<i>BAV99WT1</i>	A7	70	100	2.5	70	—	1.0	50	1.5	6.0	9
<i>BAV99RWT1</i>	F7	70	100	2.5	70	—	1.0	50	1.5	6.0	10
<i>M1MA141WKT1</i>	MT	40	100	0.1	35	—	1.2	100	2.0	3.0	5
<i>M1MA141WAT1</i>	MN	40	100	0.1	35	—	1.2	100	15	10	4

**Case 463-01 — SOT-416/SC-90 (Common Anode)**

<i>DAP222</i>	P9	80	100	100	70	—	1.2	100	3.5	4.0	4
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**Case 463-01 — SOT-416/SC-90 (Common Cathode)**

<i>DAN222</i>	N9	80	100	100	70	—	1.2	100	3.5	4.0	5
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**Table 53. Low-Leakage Medium Speed Switching Diodes — Single**

Device	Marking	V(BR)R		I <sub>R</sub>		V <sub>F</sub>			C <sub>T</sub> (30)	t <sub>rr</sub>	Case Style
		Min Volts	@ I <sub>BR</sub> (μA)	Max (nA)	@ V <sub>R</sub> Volts	Min Volts	Max Volts	@ I <sub>F</sub> (mA)	Max (pF)	Max (ns)	
<b>Case 318-08 — TO-236AB (SOT-23)</b>											
<i>BAS116LT1</i>	JV	75	100	5.0	75	—	1.0	10	2.0	3000	8
<i>MMBD1000LT1</i>	AY	30	100	0.5	30	—	0.95	10	2.0	3000	6
<b>Case 419-02 — (SOT-323)/(SC-70)</b>											
<i>MMBD2000T1</i>	DH	30	100	0.5	30	—	0.95	10	2.0	3000	2
<b>Case 318D-04 — (SC-59)</b>											
<i>MMBD3000T1</i>	XP	30	100	0.5	30	—	0.95	10	2.0	3000	2
<b>Case 425-04 — (SOD-123)</b>											
<i>MMSD1000T1</i>	4K	30	100	0.5	30	—	0.95	10	2.0	3000	1

Devices listed in bold, italic are Motorola preferred devices.

## Switching Diodes (continued)

**Table 54. Low-Leakage Medium Speed Switching Diodes — Dual**

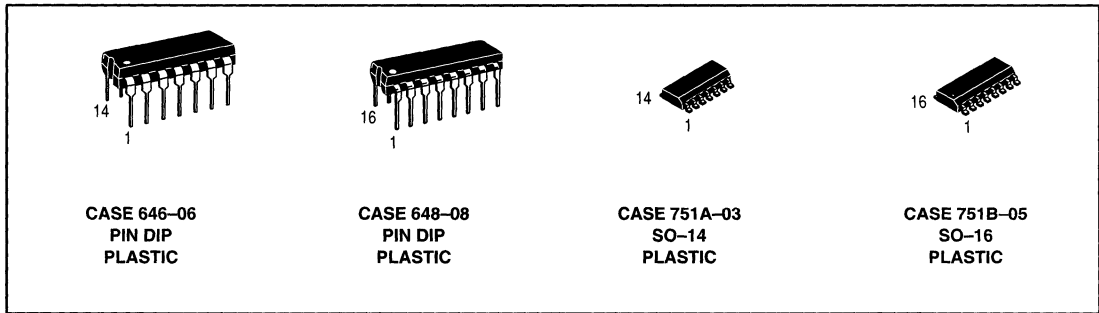
Device	Marking	$V_{(BR)R}$		$I_R$		$V_F$			$C_T^{(30)}$	$t_{rr}$	Case Style
		Min Volts	@ $I_{BR}$ ( $\mu A$ )	Max (nA)	@ $V_R$ Volts	Min Volts	Max Volts	@ $I_F$ (mA)	Max (pF)	Max (ns)	
<b>Case 318-08 — TO-236AB (SOT-23)</b>											
<i><b>BAV170LT1</b></i>	JX	70	100	5.0	70	—	1.0	10	2.0	3000	9
<i><b>BAV199LT1</b></i>	JY	70	100	5.0	70	—	1.0	10	2.0	3000	11
<i><b>BAW156LT1</b></i>	JZ	70	100	5.0	70	—	1.0	10	2.0	3000	12
<i><b>MMBD1005LT1</b></i>	A3	30	100	0.5	30	—	0.95	10	2.0	3000	12
<i><b>MMBD1010LT1</b></i>	A5	30	100	0.5	30	—	0.95	10	2.0	3000	9
<b>Case 419-02 — (SOT-323)/(SC-70) — DUAL</b>											
<i><b>MMBD2005T1</b></i>	DI	30	100	0.5	30	—	0.95	10	2.0	3000	4
<i><b>MMBD2010T1</b></i>	DP	30	100	0.5	30	—	0.95	10	2.0	3000	5
<b>Case 318D-04 — (SC-59) — DUAL</b>											
<i><b>MMBD3005T1</b></i>	XQ	30	100	0.5	30	—	0.95	10	2.0	3000	5
<i><b>MMBD3010T1</b></i>	XS	30	100	0.5	30	—	0.95	10	2.0	3000	3

<sup>(30)</sup>  $V_R = 0 V$ ,  $f = 1.0 MHz$

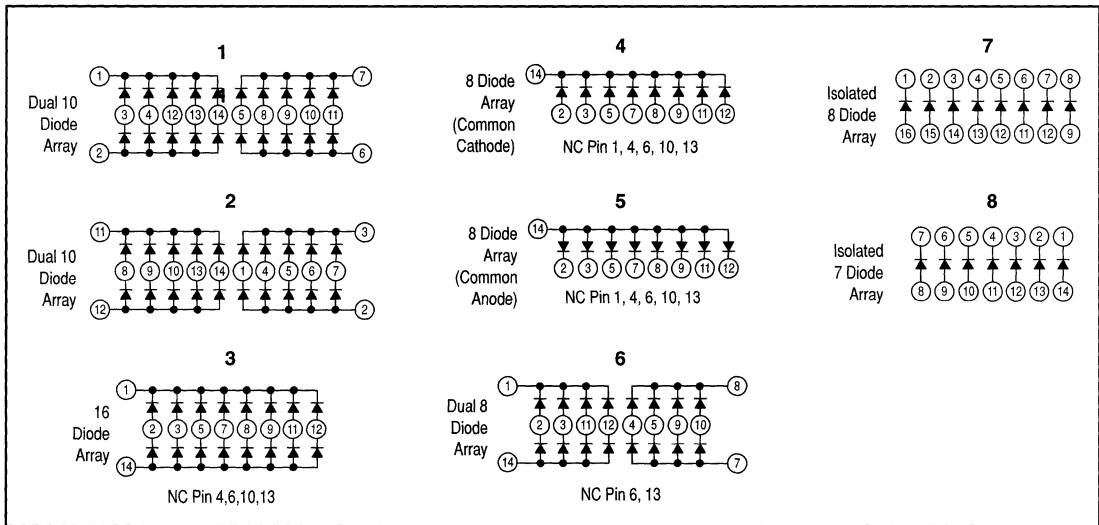
Devices listed in bold, italic are Motorola preferred devices.

# Multiple Switching Diodes

Multiple diode configurations utilize monolithic structures fabricated by the planar process. They are designed to satisfy fast switching requirements as in core driver and encoding/decoding applications where their monolithic configurations offer lower cost, higher reliability and space savings.



## Diode Array Diagrams



## Multiple Switching Diodes (continued)

Table 55. Diode Arrays

**Case 646 — TO-116**

Device	Function	Pin Connections Diagram Number
<i>MAD130P</i>	Dual 10 Diode Array	1
<i>MAD1103P</i>	16 Diode Array	3
<i>MAD1107P</i>	Dual 8 Diode Array	6
<i>MAD1109P</i>	7 Isolated Diode Array	8

**Case 648-08**

<i>MAD1108P</i>	8 Isolated Diode Array	7
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**Case 751A-03— SO-14**

<i>MMAD130</i>	Dual 10 Diode Array	2
<i>MMAD1103</i>	16 Diode Array	3
MMAD1105	8 Diode Common Cathode Array	4
MMAD1106	8 Diode Common Anode Array	5
<i>MMAD1107</i>	Dual 8 Diode Array	6
<i>MMAD1109</i>	7 Isolated Diode Array	8

**Case 751B-05 — SO-16**

<i>MMAD1108</i>	8 Isolated Diode Array	7
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Devices listed in bold, italic are Motorola preferred devices.





## Plastic-Encapsulated Surface Mount Devices

Energy. It's something Motorola is putting a lot of energy into helping save. That's why we're introducing our GreenLine™ portfolio of devices, featuring energy-conserving traits superior to those of our existing line of standard parts for the same usage. GreenLine devices can actually help reduce the power demands of your products.

### Wide Range of Applications

Currently, our portfolio consists of three families.

- **Low-Leakage Switching Diodes:** With reverse leakage specifications guaranteed to 500 pA, they help extend battery life, making them ideal for small battery-operated systems in which standby power is essential. Applications include ESD protection, reverse voltage protection, and steering logic.
- **Bipolar Output Driver Transistors:** Offering ultra-low collector saturation voltage, they deliver more energy to the intended load with less power wasted through dissipation loss. They are especially effective in today's lower voltage battery-powered applications, and prolong battery life in portable and hand-held communications and personal digital equipment.

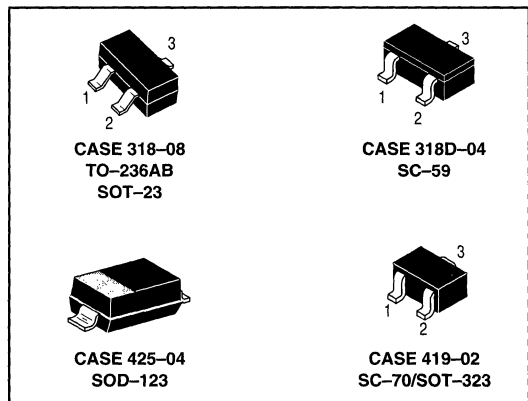
**Table 56. Bipolar Driver Transistor — PNP**

These offer ultra-low collector saturation voltage.

**Pinout: 1-Base, 2-Emitter, 3-Collector**

Device Type	Marking	Case	$V_{(BR)CEO}$	$V_{CE(sat)}$	$V_{BE(sat)}$	$hFE @ I_C$		
						Min	Max	mA
<b><i>MMBT1010LT1</i></b>	GLP	SOT-23	15	0.1	1.1	300	600	100
<b><i>MSD1010T1</i></b>	GLP	SC-59	15	0.1	1.1	300	600	100

Devices listed in bold, italic are Motorola preferred devices.



- **Small Signal HDTMOS™:** These devices provide our lowest ever drain-source resistance versus package size. Lower  $r_{DS(on)}$  means less wasted energy through dissipation loss, making them especially effective for low-current applications where energy conservation is crucial, such as low current switchmode power supplies, uninterruptable power supplies (UPS), power management systems, and bias switching. This makes them ideal for portable computer-type products or any system where the combination of power management and energy conservation is key.

### Save Energy — Save Money

In an increasingly power-hungry world, Motorola's GreenLine portfolio makes powerful sense. So much sense that we plan to continue adding devices to the portfolio. Chances are, there are Motorola GreenLine devices applicable to one or more of your products — ones that can help save energy, dollars — and the environment.

## GreenLine (continued)

**Table 57. Low Leakage Switching Diodes**

These offer reverse leakage specifications guaranteed to 500 pA. Versions available in single and dual.

Device Type	Marking	Case	Style	V(BR)R		I <sub>R</sub>	
				Min Volts	@ I <sub>BR</sub> (μA)	Max (nA)	@ V <sub>R</sub> Volts
<i>MMBD1000LT1</i>	AY	SOT-23	Single	30	100	0.5	30
<i>MMBD1005LT1</i>	A3	SOT-23	Dual Anode	30	100	0.5	30
<i>MMBD1010LT1</i>	A5	SOT-23	Dual Cathode	30	100	0.5	30
<i>MMBD2000T1</i>	DH	SC-70	Single	30	100	0.5	30
<i>MMBD2005T1</i>	DI	SC-70	Dual Anode	30	100	0.5	30
<i>MMBD2010T1</i>	DP	SC-70	Dual Cathode	30	100	0.5	30
<i>MMBD3000T1</i>	XP	SC-59	Single	30	100	0.5	30
<i>MMBD3005T1</i>	XQ	SC-59	Dual Anode	30	100	0.5	30
<i>MMBD3010T1</i>	XS	SC-59	Dual Cathode	30	100	0.5	30
<i>MMSD1000T1</i>	4K	SOD-123	Single	30	100	0.5	30

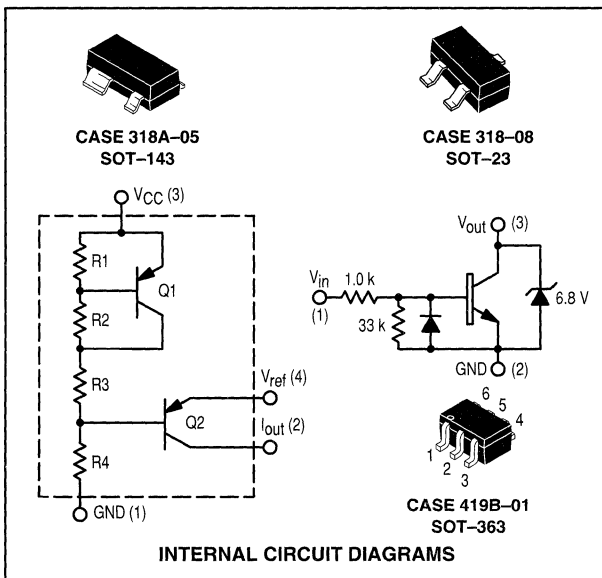
**Table 58. Small Signal HDTMOS™**

These provide the lowest drain-source resistance versus package size.

Device Type	Marking	Channel	R <sub>DS(on)</sub>		V <sub>DSS</sub>	V <sub>GS(th)</sub>		Switching Time		Style
			Ohm	mA		Volts Min	Volts Max	t <sub>(on)</sub> ns	t <sub>(off)</sub> ns	
<b>Case 318-08 — TO-236AB (SOT-23) — P-Channel and N-Channel</b>										
<i>MMBF0201NLT1</i>	N1	N	1.0	300	20	1.0	2.4	2.5	15	21
<i>MMBF0202PLT1</i>	P3	P	1.4	200	20	1.0	2.4	2.5	16	21
<i>MGSF1N02LT1</i>	—	N	0.08	2000	20	1.0	2.4	2.5	16	21
<i>MGSF1N03LT1</i>	—	N	0.09	2000	30	1.0	2.4	2.5	16	21
<i>MGSF1P02LT1</i>	—	P	0.20	1500	20	1.0	2.4	2.5	16	21
<i>MGSF1P02ELT1</i>	—	P	0.16	1500	20	0.7	1.0	2.5	16	21
<b>Case 419-02 — SC-70/SOT-323</b>										
<i>MMBF2202PT1</i>	P3	P	1.5	200	20	1.0	2.4	2.5	16	7
<i>MMBF2201NT1</i>	N1	N	0.7	300	20	1.0	2.4	2.5	15	7

Devices listed in bold, italic are Motorola preferred devices.

# Small Signal Multi-integrated Devices



**Table 59. Low Voltage Bias Stabilizer**

A silicon SMALLBLOCK™ integrated circuit which maintains stable bias current in various discrete bipolar junction and field effect transistors.

Device Type	Marking	V <sub>CC</sub> (Volts)		I <sub>CC</sub> μA	V <sub>ref</sub> Volts	ΔV <sub>ref</sub> Volts
		Min	Max			
<b>Case 318A-05 — SOT-143</b>						
MDC5000T1	E5	1.8	10	200	2.1	±50
<b>Case 419B-01 — SOT-363</b>						
MDC5001T1	E6	1.8	10	200	2.1	±50

**Table 60. Integrated Relay/Solenoid Driver**

Monolithic circuit block to switch 3.0 V to 5.0 V relays. It is intended to replace an array of three to six discrete components.

Device Type	V <sub>CC</sub> (Volts)		V <sub>in</sub> (Volts)		V <sub>sat</sub> (Volts)	I <sub>in</sub> (mA)	I <sub>C(on)</sub> (mA)
	Min	Max	Min	Max			
<b>Case 318-08 — SOT-23</b>							
<b><i>MDC3105LT1</i></b>	2.0	5.5	2.0	5.5	0.4	2.5	250

Devices listed in bold, italic are Motorola preferred devices.

Devices listed in bold, italic are Motorola preferred devices.

# TVS/Zeners

## Transient Voltage Suppressors

## Zener Regulator and Reference Diodes

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### In Brief . . .

Motorola's standard TVS (Transient Voltage Suppressors) and Zener diodes comprise the largest inventoried line in the industry. Continuous development of improved manufacturing techniques have resulted in computerized diffusion and test, as well as critical process controls learned from surface-sensitive MOS fabrication. Resultant high yields lower factory costs. Check the following features for application to your specific requirements:

- Wide selection of package materials and styles:
  - Plastic (Surmetic) for low cost, mechanical ruggedness
  - Glass for high reliability, low cost
  - Surface Mount packages for state of the art designs
- Power Ratings from 0.25 to 5.0 Watts
- Breakdown voltages from 1.8 to 400 Volts in approximately 10% steps
- TVS from 24 to 1500 Watts and from 6.2 to 250 Volts
- ESD protection devices
- Special selection of electrical characteristics available at low cost due to high-volume lines (check your Motorola sales representative for special quotations)
- UL Recognition on many TVS device types
- Tape and Reel options available on all axial leaded and surface mount types

	<b>Page</b>
TVS (Transient Voltage Suppressors) . . . . .	5.2-2
General-Purpose . . . . .	5.2-2
Axial Leaded for Through-hole Designs . . . . .	5.2-2
Surface Mount Packages . . . . .	5.2-9
Overvoltage Transient Suppressors . . . . .	5.2-18
Zener Diodes . . . . .	5.2-19
Voltage Regulator Diodes . . . . .	5.2-19
Notes — Axial Leaded Chart . . . . .	5.2-23
Notes — Surface Mount Chart . . . . .	5.2-26
Voltage Reference Diodes . . . . .	5.2-34
Current Regulator Diodes . . . . .	5.2-34

Note: Any TVS/Zener device not listed in this Master Selection Guide may be available with a special order. Please contact your Motorola representative for details.

# TVS (Transient Voltage Suppressors)

## General–Purpose

Transient Voltage Suppressors are designed for applications requiring protection of voltage sensitive electronic devices in danger of destruction by high energy voltage transients. Many of the zener voltage regulator diodes listed in the previous charts are in fact used in circuits as transient voltage suppressors. The purpose of this section is to present the families of Motorola Zeners that are specified with the key transient voltage suppressor parameters and limits, e.g., maximum clamping voltage at maximum surge current rating and working peak reverse (stand–off) voltage.


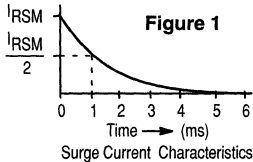
Selection sequence:

1. Package type (axial or surface mount)
2. Peak surge power expected for the application
3. Working peak reverse stand–off voltage (or the breakdown voltage)
4. Maximum reverse clamping voltage

Consult the factory for special electrical selections if there is no standard device type available to fit the application.

## Axial Leaded for Through–hole Designs

**Table 1. Peak Power Dissipation<sup>(1)</sup> (500 Watts @ 1 ms Surge – Figure 1)**  
Case 59–04 — Mini Mosorb

 							
ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ unless otherwise noted) $V_F = 3.5\text{ V Max}$ , $I_F = 35\text{ A Pulse}$ (except bidirectional devices).							
Working Peak Reverse Voltage $V_{RWM}$ (Volts)	Device <sup>(2)</sup>	Breakdown Voltage			Maximum Reverse Leakage @ $V_{RWM}$ $I_R$ ( $\mu\text{A}$ )	Maximum Reverse Surge Current $I_{RSM}$ Figure 1 (Amps)	Maximum Reverse Voltage @ $I_{RSM}$ (Clamping Voltage) $V_{RSM}$ (Volts)
		$V_{BR}$ (Volts)		@ $I_T$ Pulse (mA)			
		Min	Max				
5	<b>SA5.0A</b>	6.4	7	10	600	54.3	9.2
6	<b>SA6.0A</b>	6.67	7.37	10	600	48.5	10.3
7	SA7.0A	7.78	8.6	10	150	41.7	12
8	SA8.0A	8.89	9.83	1	25	36.7	13.6
11	<b>SA11A</b>	12.2	13.5	1	1	27.4	18.2
12	<b>SA12A</b>	13.3	14.7	1	1	25.1	19.9
13	SA13A	14.4	15.9	1	1	23.2	21.5
14	SA14A	15.6	17.2	1	1	21.5	23.2
15	<b>SA15A</b>	16.7	18.5	1	1	20.6	24.4
16	SA16A	17.8	19.7	1	1	19.2	26
17	SA17A	18.9	20.9	1	1	18.1	27.6

(1) Steady state power dissipation = 3 watt max rating

(2) For bidirectional types use CA suffix, **SA6.5CA**, **SA12CA**, **SA13CA** and **SA15CA** are Motorola preferred devices. Have cathode polarity band on each end. (Consult factory for availability).

Devices listed in bold, italic are Motorola preferred devices.

# TVS

## Axial Leaded for Through-hole Designs (continued)

Table 1. Peak Power Dissipation<sup>(1)</sup> (500 Watts @ 1 ms Surge – Figure 1)  
Case 59-04 — Mini Mosorb (continued)

ELECTRICAL CHARACTERISTICS (T <sub>A</sub> = 25°C unless otherwise noted) V <sub>F</sub> = 3.5 V Max, I <sub>F</sub> = 35 A Pulse (except bidirectional devices).							
Working Peak Reverse Voltage V <sub>RWM</sub> (Volts)	Device <sup>(2)</sup>	Breakdown Voltage			Maximum Reverse Leakage @ V <sub>RWM</sub> I <sub>R</sub> (μA)	Maximum Reverse Surge Current I <sub>RSM</sub> Figure 1 (Amps)	Maximum Reverse Voltage @ I <sub>RSM</sub> (Clamping Voltage) V <sub>RSM</sub> (Volts)
		V <sub>BR</sub> (Volts)		@ I <sub>T</sub> Pulse (mA)			
		Min	Max				
20	SA20A	22.2	24.5	1	1	15.4	32.4
24	SA24A	26.7	29.5	1	1	12.8	38.9
26	SA26A	28.9	31.9	1	1	11.9	42.1
28	SA28A	31.1	34.4	1	1	11	45.4
30	SA30A	33.3	36.8	1	1	10.3	48.4
36	SA36A	40	44.2	1	1	8.6	58.1
51	SA51A	56.7	62.7	1	1	6.1	82.4
58	SA58A	64.4	71.2	1	1	5.3	93.6
60	SA60A	66.7	73.7	1	1	5.2	96.8
75	SA75A	83.3	92.1	1	1	4.1	121
78	SA78A	86.7	95.8	1	1	4	126
90	<b>SA90A</b>	100	111	1	1	3.4	146
110	SA110A	122	135	1	1	2.8	177
130	SA130A	144	159	1	1	2.4	209
160	SA160A	178	197	1	1	1.9	259
170	SA170A	189	209	1	1	1.8	275

(1) Steady state power dissipation = 3 watt max rating

(2) For bidirectional types, use CA suffix.

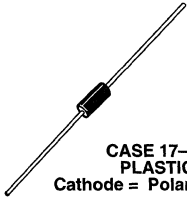
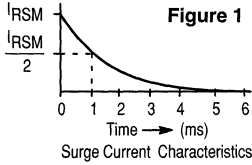
Have cathode polarity band on each end. (Consult factory for availability).

Devices listed in bold, italic are Motorola preferred devices.

# TVS

## Axial Led for Through-hole Designs (continued)

Table 2. Peak Power Dissipation<sup>(2)</sup> (600 Watts @ 1 ms Surge – Figure 1)  
Case 17-02 — Surmetic 40

 <p><b>CASE 17-02 PLASTIC</b> Cathode = Polarity Band</p>		 <p><b>Figure 1</b> Surge Current Characteristics</p>				
<b>ELECTRICAL CHARACTERISTICS</b> ( $T_A = 25^\circ\text{C}$ unless otherwise noted) $V_F = 3.5\text{ V Max}$ , $I_F = 50\text{ A Pulse}$ (except bidirectional devices).						
Breakdown Voltage <sup>(3)</sup>		Device <sup>(1, 4)</sup>	Working Peak Reverse Voltage $V_{RWM}$ (Volts)	Maximum Reverse Leakage @ $V_{RWM}$ $I_R$ ( $\mu\text{A}$ )	Maximum Reverse Surge Current $I_{RSM}$ Figure 1 (Amps)	Maximum Reverse Voltage @ $I_{RSM}$ (Clamping Voltage) $V_{RSM}$ (Volts)
$V_{BR}$ (Volts)	@ $I_T$ Pulse (mA)					
Nom						
6.8	10	<b><i>P6KE6.8A</i></b>	5.8	1000	57	10.5
7.5	10	P6KE7.5A	6.4	500	53	11.3
8.2	10	P6KE8.2A	7.02	200	50	12.1
9.1	1	P6KE9.1A	7.78	50	45	13.4
10	1	P6KE10A	8.55	10	41	14.5
11	1	P6KE11A	9.4	5	38	15.6
12	1	P6KE12A	10.2	5	36	16.7
13	1	P6KE13A	11.1	5	33	18.2
15	1	<b><i>P6KE15A</i></b>	12.8	5	28	21.2
16	1	P6KE16A	13.6	5	27	22.5
18	1	P6KE18A	15.3	5	24	25.2
20	1	P6KE20A	17.1	5	22	27.7
22	1	P6KE22A	18.8	5	20	30.6
24	1	P6KE24A	20.5	5	18	33.2
27	1	P6KE27A	23.1	5	16	37.5
30	1	P6KE30A	25.6	5	14.4	41.4
33	1	P6KE33A	28.2	5	13.2	45.7
36	1	P6KE36A	30.8	5	12	49.9
39	1	P6KE39A	33.3	5	11.2	53.9
43	1	P6KE43A	36.8	5	10.1	59.3
47	1	P6KE47A	40.2	5	9.3	64.8
51	1	P6KE51A	43.6	5	8.6	70.1
56	1	P6KE56A	47.8	5	7.8	77
62	1	P6KE62A	53	5	7.1	85
68	1	P6KE68A	58.1	5	6.5	92
75	1	P6KE75A	64.1	5	5.8	103
82	1	P6KE82A	70.1	5	5.3	113
91	1	P6KE91A	77.8	5	4.8	125
120	1	P6KE120A	102	5	3.6	165

(1) For bidirectional types use CA suffix, ***P6KE7.5CA*** and ***P6KE11CA*** are Motorola preferred devices.

Have cathode polarity band on each end. (Consult factory for availability).

(2) Steady state power dissipation = 5 watt max rating.

(3) Breakdown voltage tolerance is  $\pm 5\%$  for A suffix.

(4) UL recognition for classification of protectors (QGV2) under the UL standard for safety 497B and file #E116110 for entire series including CA suffixes.

Devices listed in bold, italic are Motorola preferred devices.



# TVS

## Axial Leaded for Through-hole Designs (continued)

**Table 2. Peak Power Dissipation<sup>(2)</sup> (600 Watts @ 1 ms Surge – Figure 1)**  
**Case 17-02 — Surmetic 40 (continued)**

<b>ELECTRICAL CHARACTERISTICS</b> ( $T_A = 25^\circ\text{C}$ unless otherwise noted) $V_F = 3.5\text{ V Max}$ , $I_F = 50\text{ A Pulse}$ (except bidirectional devices).						
Breakdown Voltage <sup>(3)</sup>		Device <sup>(1, 4)</sup>	Working Peak Reverse Voltage $V_{RWM}$ (Volts)	Maximum Reverse Leakage @ $V_{RWM}$ $I_R$ ( $\mu\text{A}$ )	Maximum Reverse Surge Current $I_{RSM}$ Figure 1 (Amps)	Maximum Reverse Voltage @ $I_{RSM}$ (Clamping Voltage) $V_{RSM}$ (Volts)
$V_{BR}$ (Volts)	@ $I_T$ Pulse (mA)					
Nom						
130	1	P6KE130A	111	5	3.3	179
150	1	P6KE150A	128	5	2.9	207
160	1	P6KE160A	136	5	2.7	219
180	1	P6KE180A	154	5	2.4	246
200	1	P6KE200A	171	5	2.2	274

(1) For bidirectional types use CA suffix. Have cathode polarity band on each end. (Consult factory for availability).

(2) Steady state power dissipation = 5 watt max rating.


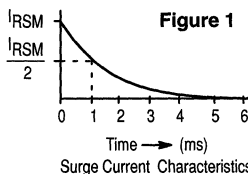
(3) Breakdown voltage tolerance is  $\pm 5\%$  for A suffix.

(4) UL recognition for classification of protectors (QVGV2) under the UL standard for safety 497B and file #E116110 for entire series including CA suffixes.

# TVS

## Axial Led for Through-hole Designs (continued)

Table 3. Peak Power Dissipation<sup>(1)</sup> (1500 WATTS @ 1 ms Surge – Figure 1)  
Case 41A-02 — Mosorb

 <p>CASE 41A-02 PLASTIC Cathode = Polarity Band</p>		 <p>Figure 1 Surge Current Characteristics</p>							
				<p><b>ELECTRICAL CHARACTERISTICS</b> (<math>T_A = 25^\circ\text{C}</math> unless otherwise noted) <math>V_F = 3.5\text{ V Max}</math>, <math>I_F = 100\text{ A Pulse}</math> (C suffix denotes standard back to back bidirectional versions. Test both polarities)</p>					
Maximum Reverse Stand-Off Voltage $V_{RWM}$ (Volts)	JEDEC <sup>(2)</sup> Device	Device <sup>(2)</sup>	Breakdown Voltage		Maximum Reverse Leakage @ $V_{RWM}$ $I_R$ ( $\mu\text{A}$ )	Maximum Reverse Surge Current Figure 1 $I_{RSM}$ (Volts)	Maximum Reverse Voltage @ $I_{RSM}$ (Clamping Voltage) $V_{RSM}$ (Volts)	Clamping Voltage <sup>(3)</sup>	
			$V_{BR}$ Volts Min	@ $I_T$ Pulse (mA)				Peak Pulse Current @ $I_{pp1} = 1\text{ A}$ Figure 1 $V_{C1}$ (Volts max)	Peak Pulse Current @ $I_{pp2} = 10\text{ A}$ Figure 1 $V_{C2}$ (Volts max)
5	<b>1N5908</b>		6	1	300	120	8.5	7.6 @ 30 A	8 @ 60 A

<sup>(1)</sup> Steady state power dissipation = 5 watts max rating.

<sup>(2)</sup> 1N6382 thru 1N6389 and C suffix ICTE/MPTE device types are bidirectional. Have cathode polarity band on each end. All other device types are unidirectional only. (Consult factory for availability)

<sup>(3)</sup> Clamping voltage peak pulse currents for 1N5908 are 30 Amps and 60 Amps.

Devices listed in bold, italic are Motorola preferred devices.

# TVS

## Axial Led for Through-hole Designs (continued)

Table 4. Peak Power Dissipation<sup>(1)</sup> (1500 Watts @ 1 ms Surge – Figure 1)  
Case 41A-02 – Mosorb

Breakdown Voltage <sup>(2)</sup>		JEDEC Device	Device <sup>(3, 4)</sup>	Working Peak Reverse Voltage $V_{RWM}$ (Volts)	Maximum Reverse Leakage @ $V_{RWM}$ $I_R$ ( $\mu$ A)	Maximum Reverse Surge Current Figure 1 $I_{RSM}$ (Amps)	Maximum Reverse Voltage @ $I_{RSM}$ (Clamping Voltage) $V_{RSM}$ (Volts)
$V_{BR}$ Volts	@ $I_T$ Pulse (mA)						
Nom							
6.8	10	<b>1N6267A</b>	1.5KE6.8A	5.8	1000	143	10.5
7.5	10	1N6268A	1.5KE7.5A	6.4	500	132	11.3
8.2	10	1N6269A	1.5KE8.2A	7.02	200	124	12.1
10	1	1N6271A	1.5KE10A	8.55	10	103	14.5
11	1	1N6272A	1.5KE11A	9.4	5	96	15.6
12	1	1N6273A	1.5KE12A	10.2	5	90	16.7
13	1	1N6274A	1.5KE13A	11.1	5	82	18.2
15	1	<b>1N6275A</b>	1.5KE15A	12.8	5	71	21.2
16	1	1N6276A	1.5KE16A	13.6	5	67	22.5
18	1	1N6277A	1.5KE18A	15.3	5	59.5	25.2
20	1	1N6278A	1.5KE20A	17.1	5	54	27.7
22	1	1N6279A	<b>1.5KE22A</b>	18.8	5	49	30.6
24	1	<b>1N6280A</b>	1.5KE24A	20.5	5	45	33.2
27	1	<b>1N6281A</b>	1.5KE27A	23.1	5	40	37.5
30	1	<b>1N6282A</b>	1.5KE30A	25.6	5	36	41.4
33	1	<b>1N6283A</b>	1.5KE33A	28.2	5	33	45.7
36	1	1N6284A	1.5KE36A	30.8	5	30	49.9
39	1	<b>1N6285A</b>	<b>1.5KE39A</b>	33.3	5	28	53.9
43	1	1N6286A	1.5KE43A	36.8	5	25.3	59.3
47	1	1N6287A	1.5KE47A	40.2	5	23.2	64.8
51	1	<b>1N6288A</b>	1.5KE51A	43.6	5	21.4	70.1
56	1	1N6289A	1.5KE56A	47.8	5	19.5	77
62	1	1N6290A	1.5KE62A	53	5	17.7	85
68	1	1N6291A	1.5KE68A	58.1	5	16.3	92
75	1	1N6292A	1.5KE75A	64.1	5	14.6	103
82	1	1N6293A	1.5KE82A	70.1	5	13.3	113
91	1	1N6294A	1.5KE91A	77.8	5	12	125
100	1	1N6295A	1.5KE100A	85.5	5	11	137
110	1	1N6296A	1.5KE110A	94	5	9.9	152
120	1	1N6297A	1.5KE120A	102	5	9.1	165
130	1	1N6298A	1.5KE130A	111	5	8.4	179

(1) Steady state power dissipation = 5 watts max rating.

(2) Breakdown voltage tolerance is  $\pm 5\%$  for A suffix.

(3) For bidirectional types use CA suffix on 1.5KE series only. Have cathode polarity band on each end. (Consult factory for availability)

1N6267–6303A series do not have CA option since the CA is not included in EIA Registration.

(4) UL recognition for classification of protectors (QVGV2) under the UL standard for safety 497B and file #E116110 for 1.5KE6.8A, CA thru 1.5KE250A, CA.

Devices listed in bold, italic are Motorola preferred devices.

# TVS

## Axial Leaded for Through-hole Designs (continued)

**Table 4. Peak Power Dissipation<sup>(1)</sup> (1500 Watts @ 1 ms Surge – Figure 1)**  
**Case 41A-02 – Mosorb (continued)**

<b>ELECTRICAL CHARACTERISTICS</b> ( $T_A = 25^\circ\text{C}$ unless otherwise noted) $V_F = 3.5\text{ V Max}$ , $I_F = 100\text{ A Pulse}$							
<b>Breakdown Voltage<sup>(2)</sup></b>		<b>JEDEC Device</b>	<b>Device<sup>(3, 4)</sup></b>	<b>Working Peak Reverse Voltage <math>V_{RWM}</math> (Volts)</b>	<b>Maximum Reverse Leakage @ <math>V_{RWM}</math> <math>I_R</math> (<math>\mu\text{A}</math>)</b>	<b>Maximum Reverse Surge Current Figure 1 <math>I_{RSM}</math> (Amps)</b>	<b>Maximum Reverse Voltage @ <math>I_{RSM}</math> (Clamping Voltage) <math>V_{RSM}</math> (Volts)</b>
<b><math>V_{BR}</math> Volts</b>	<b>@ <math>I_T</math> Pulse (mA)</b>						
<b>Nom</b>							
150	1	1N6299A	1.5KE150A	128	5	7.2	207
160	1	1N6300A	1.5KE160A	136	5	6.8	219
170	1	1N6301A	1.5KE170A	145	5	6.4	234
180	1	1N6302A	1.5KE180A	154	5	6.1	246
200	1	1N6303A	1.5KE200A	171	5	5.5	274
220	1		1.5KE220A	185	5	4.6	328
250	1		1.5KE250A	214	5	5	344

(1) Steady state power dissipation = 5 watts max rating.

(2) Breakdown voltage tolerance is  $\pm 5\%$  for A suffix.

(3) For bidirectional types use CA suffix. Have cathode polarity band on each end. (Consult factory for availability).  
 1N6267–6303A series do not have CA option since the CA is not included in EIA Registration.

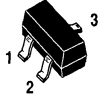
(4) UL recognition for classification of protectors (QVGV2) under the UL standard for safety 497B and file #E116110 for 1.5KE6.8A, CA thru 1.5KE250A, CA.

# Surface Mount Packages

**Table 5. Peak Power Dissipation (40 Watts @ 1 ms Surge – Figure 1)(1)**

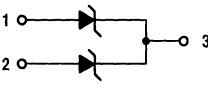
**Case 318-08 — Common Cathode**

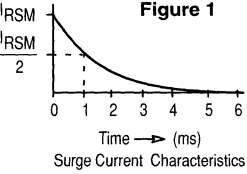
**MMBZ15VDLT1, MMBZ27VCLT1(2) — SOT-23 Dual Monolithic Common Cathode Bipolar Zener (for ESD protection)**



**CASE 318-08, STYLE 9**  
**TO-236AB**  
**LOW PROFILE SOT-23**  
**PLASTIC**

**Pinout:** TERMINAL 1 — ANODE  
TERMINAL 2 — ANODE  
TERMINAL 3 — COMMON CATHODE





**Figure 1**  
Surge Current Characteristics

**ELECTRICAL CHARACTERISTICS** ( $T_A = 25^\circ\text{C}$  unless otherwise noted)

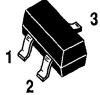
**BIDIRECTIONAL** (Circuit tied to pins 1 and 2)

Breakdown Voltage				Working Peak Reverse Voltage $V_{RWM}$ (Volts)	Maximum Reverse Leakage Current $I_{RWM}$ $I_R$ (nA)	Maximum Reverse Surge Current $I_{RSM}$ (Amps)	Maximum Reverse Voltage @ $I_{RMS}$ (Clamping Voltage) $V_{RSM}$ (Volts)	Maximum Temperature Coefficient of $V_{BR}$ ( $\text{mV}/^\circ\text{C}$ )
$V_{BR}^{(3)}$ (Volts)			@ $I_T$ (mA)					
Min	Nom	Max						
14.3	15	15.8	1.0	12.8	100	1.9	21.2	12
25.65	27	28.35	1.0	22	50	1.0	38	26

**Table 6. Peak Power Dissipation (24 Watts @ 1 ms Surge – Figure 1)(1)**

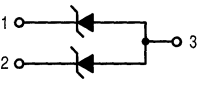
**Case 318-08 — Common Anode**

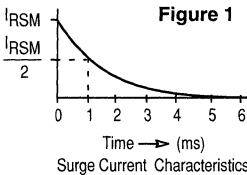
**MMBZ5V6ALT1, MMBZ6V2ALT1, MMBZ15ALT1, MMBZ20ALT1(2) — SOT-23 Dual Monolithic Common Anode Zener (for ESD Protection)**



**CASE 318-08, STYLE 12**  
**TO-236AB**  
**LOW PROFILE SOT-23**  
**PLASTIC**

**PIN 1. CATHODE**  
**2. CATHODE**  
**3. COMMON ANODE**





**Figure 1**  
Surge Current Characteristics

**ELECTRICAL CHARACTERISTICS** ( $T_A = 25^\circ\text{C}$  unless otherwise noted)

**UNIDIRECTIONAL** (Circuit tied to pins 1 and 3 or Pins 2 and 3) ( $V_F = 0.9\text{ V Max @ } I_F = 10\text{ mA}$ )

Breakdown Voltage				Max Reverse Leakage Current		Max Zener Impedance(4)			Max Reverse Surge Current $I_{RSM}$ (A)	Max Reverse Voltage @ $I_{RSM}$ (Clamping Voltage) $V_{RSM}$ (V)	Maximum Temperature Coefficient of $V_{BR}$ ( $\text{mV}/^\circ\text{C}$ )
$V_{BR}^{(3)}$ (Volts)			@ $I_T$ (mA)	$I_R$ @ $V_R$ ( $\mu\text{A}$ )	$V_R$ (V)	$Z_{ZT}$ @ $I_T$ ( $\Omega$ )	$Z_{ZK}$ @ $I_{ZK}$ ( $\Omega$ )	@ $I_{ZK}$ (mA)			
Min	Nom	Max									
5.32	5.6	5.88	20	5.0	3.0	11	1600	0.25	3.0	8.0	1.26
5.89	6.2	6.51	1.0	0.5	3.0	220			2.76	8.7	2.80
14.25	15	15.75	1.0	0.05	12	100			1.9	21	12.3
19	20	21	1.0	0.05	17	100			1.4	28	17

(1) Other voltages may be available upon request. Contact your Motorola representative.

(2) T1 suffix designates tape and reel of 3000 units.

(3)  $V_{BR}$  measured at pulse test current  $I_T$  at an ambient temperature of  $25^\circ\text{C}$ .


(4)  $Z_{ZT}$  and  $Z_{ZK}$  are measured by dividing the AC voltage drop across the device by the AC current supplied.

The specified limits are  $I_{Z(AC)} = 0.1 I_{Z(DC)}$ , with AC frequency = 1 kHz.

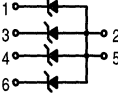
# TVS

## Surface Mount Packages (continued)

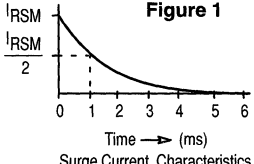
**Table 7. Peak Power Dissipation (24 Watts @ 1 ms Surge – Figure 1)**  
**Case 318F-01—Monolithic 4-Function Device**  
**MMQA5V6T1, MMQA20VT1(1) — SC-59 Quad Transient Voltage Suppressor (for ESD Protection)**



**CASE 318F-02**  
**SC-59**  
**PLASTIC**



PIN 1. CATHODE  
 2. ANODE  
 3. CATHODE  
 4. CATHODE  
 5. ANODE  
 6. CATHODE



**Figure 1**  
Surge Current Characteristics

**ELECTRICAL CHARACTERISTICS** ( $T_A = 25^\circ\text{C}$  unless otherwise noted)  
**UNIDIRECTIONAL** (Circuit tied to pins 1, 2, and 5; Pins 2, 3, and 5; Pins 2, 4, and 5; or Pins 2, 5, and 6) ( $V_F = 0.9\text{ V Max @ } I_F = 10\text{ mA}$ )

Device	Breakdown Voltage			Max Reverse Leakage Current		Max Zener Impedance(2)	Max Reverse Surge Current $I_{RSM}^{(4)}$ (Amps)	Max Reverse Voltage @ $I_{RSM}$ (Clamping Voltage) $V_{RSM}$ (Volts)	Maximum Temperature Coefficient of $V_Z$ (mV/°C)
	$V_{ZT}^{(1)}$ (Volts)			$I_R$ ( $\mu\text{A}$ )	$V_R$ (Volts)	$Z_{ZT}$ @ $I_{ZT}$ ( $\Omega$ )			
	Min	Nom	Max						
MMQA5V6T1,T3	5.32	5.6	5.88	1.0	2000	3.0	3.0	8.0	1.26
MMQA6V2T1,T3	5.89	6.2	6.51	1.0	700	4.0	2.66	9.0	10.6
MMQA6V8T1,T3	6.46	6.8	7.14	1.0	500	4.3	2.45	9.8	10.9
MMQA12VT1,T3	11.4	12	12.6	1.0	75	9.1	1.39	17.3	14
MMQA13VT1,T3	12.4	13	13.7	1.0	75	9.8	1.29	18.6	15
MMQA15VT1,T3	14.3	15	15.8	1.0	75	11	1.1	21.7	16
MMQA18VT1,T3	17.1	18	18.9	1.0	75	14	0.923	26.0	19
MMQA20VT1,T3	19	20	21	1.0	75	15	0.84	28.6	20.1
MMQA21VT1,T3	20	21	22.1	1.0	75	16	0.792	30.3	21
MMQA22VT1,T3	20.9	22	23.1	1.0	75	17	0.758	31.7	22
MMQA24VT1,T3	22.8	24	25.2	1.0	75	18	0.694	34.6	25
MMQA27VT1,T3	25.7	27	28.4	1.0	75	21	0.615	39	28
MMQA30VT1,T3	28.5	30	31.5	1.0	75	23	0.554	43.3	32
MMQA33VT1,T3	31.4	33	34.7	1.0	75	25	0.504	47.6	37


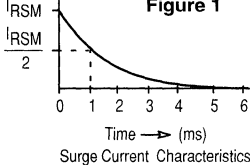
(1)  $V_Z$  measured at pulse test current  $I_T$  at an ambient temperature of  $25^\circ\text{C}$ .  
 (2)  $Z_{ZT}$  is measured by dividing the AC voltage drop across the device by the AC current supplied. The specified limits are  $I_{Z(AC)} = 0.1 I_{Z(DC)}$ , with AC frequency = 1 kHz.

Devices listed in bold, italic are Motorola preferred devices.

# TVS

## Surface Mount Packages (continued)


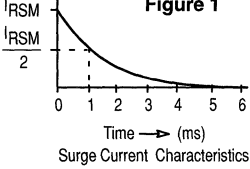
Table 8. Peak Power Dissipation — Case 403B-01

 <b>CASE 403B-01</b> <b>SMA</b> <b>PLASTIC</b>				 <b>Figure 1</b> Surge Current Characteristics			
Device	Reverse Stand-off Voltage $V_{RWM}$ (Volts)	Breakdown Voltage		Maximum Reverse Voltage @ $I_{RSM}$ (Clamping Voltage) $V_{RSM}$ (Volts)	Maximum Reverse Surge Current $I_{RSM}$ (Amps)	Maximum Reverse Leakage @ $V_{RWM}$ $I_R$ ( $\mu A$ )	Device Marking
		$V_{BR}$ Volts (Min)	$I_T$ mA				
1SMA5.0AT3	5.0	6.4	10	9.2	43.5	400	QE
1SMA6.0AT3	6.0	6.67	10	10.3	38.8	400	QG
1SMA6.5AT3	6.5	7.22	10	11.2	35.7	250	QK
1SMA7.0AT3	7.0	7.78	10	12.0	33.3	250	QM
1SMA7.5AT3	7.5	8.33	1	12.9	31.0	50	QP
1SMA8.0AT3	8.0	8.89	1	13.6	29.4	25	QR
1SMA8.5AT3	8.5	9.44	1	14.4	27.8	5.0	QT
1SMA9.0AT3	9.0	10	1	15.4	26.0	2.5	QV
1SMA10AT3	10	11.1	1	17.0	23.5	2.5	QX
1SMA11AT3	11	12.2	1	18.2	22.0	2.5	QZ
1SMA12AT3	12	13.3	1	19.9	20.1	2.5	RE
1SMA13AT3	13	14.4	1	21.5	18.6	2.5	RG
1SMA14AT3	14	15.6	1	23.2	17.2	2.5	RK
1SMA15AT3	15	16.7	1	24.4	16.4	2.5	RM
1SMA16AT3	16	17.8	1	26.0	15.4	2.5	RP
1SMA17AT3	17	18.9	1	27.6	14.5	2.5	RR
1SMA18AT3	18	20	1	29.2	13.7	2.5	RT
1SMA20AT3	20	22.2	1	32.4	12.3	2.5	RV
1SMA22AT3	22	24.4	1	35.5	11.3	2.5	RX
1SMA24AT3	24	26.7	1	38.9	10.3	2.5	RZ
1SMA26AT3	26	28.9	1	42.1	9.5	2.5	SE
1SMA28AT3	28	31.1	1	45.4	8.8	2.5	SG
1SMA30AT3	30	33.3	1	48.4	8.3	2.5	SK
1SMA33AT3	33	36.7	1	53.3	7.5	2.5	SM
1SMA36AT3	36	40	1	58.1	6.9	2.5	SP
1SMA40AT3	40	44.4	1	64.5	6.2	2.5	SR
1SMA43AT3	43	47.8	1	69.4	5.8	2.5	ST
1SMA45AT3	45	50	1	72.2	5.5	2.5	SV
1SMA48AT3	48	53.3	1	77.4	5.2	2.5	SX
1SMA51AT3	51	56.7	1	82.4	4.9	2.5	SZ
1SMA54AT3	54	60	1	87.1	4.6	2.5	TE
1SMA58AT3	58	64.4	1	93.6	4.8	2.5	TG
1SMA60AT3	60	66.7	1	96.8	4.1	2.5	TK
1SMA64AT3	64	71.1	1	103.0	3.9	2.5	TM
1SMA70AT3	70	77.8	1	113.0	3.5	2.5	TP
1SMA75AT3	75	83.3	1	121.0	3.3	2.5	TR

# TVS

## Surface Mount Packages (continued)

Table 8. Peak Power Dissipation — Case 403B-01 (continued)


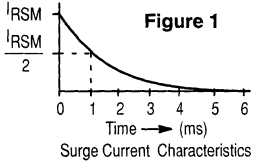
<div style="display: flex; justify-content: space-between; align-items: center;"> <div style="text-align: center;">  <p><b>CASE 403B-01</b> <b>SMA</b> <b>PLASTIC</b></p> </div> <div style="text-align: right;">  <p><b>Figure 1</b> Surge Current Characteristics</p> </div> </div>							
<b>ELECTRICAL CHARACTERISTICS</b> ( $V_F = 3.5$ Volts @ $I_F = 40$ A for all types)							
Device	Reverse Stand-off Voltage $V_{RWM}$ (Volts)	Breakdown Voltage		Maximum Reverse Voltage @ $I_{RSM}$ (Clamping Voltage) $V_{RSM}$ (Volts)	Maximum Reverse Surge Current $I_{RSM}$ (Amps)	Maximum Reverse Leakage @ $V_{RWM}$ $I_R$ ( $\mu$ A)	Device Marking
		$V_{BR}$ Volts (Min)	$I_T$ mA				
1SMA10CAT3	10	11.1	1	17.0	23.5	2.5	QXC
1SMA11CAT3	11	12.2	1	18.2	22.0	2.5	QZC
1SMA12CAT3	12	13.3	1	19.9	20.1	2.5	REC
1SMA13CAT3	13	14.4	1	21.5	18.6	2.5	RGC
1SMA14CAT3	14	15.6	1	23.2	17.2	2.5	RKC
1SMA15CAT3	15	16.7	1	24.4	16.4	2.5	RMC
1SMA16CAT3	16	17.8	1	26.0	15.4	2.5	RPC
1SMA17CAT3	17	18.9	1	27.6	14.5	2.5	RRC
1SMA18CAT3	18	20	1	29.2	13.7	2.5	RTC
1SMA20CAT3	20	22.2	1	32.4	12.3	2.5	RVC
1SMA22CAT3	22	24.4	1	35.5	11.3	2.5	RXC
1SMA24CAT3	24	26.7	1	38.9	10.3	2.5	RZC
1SMA26CAT3	26	28.9	1	42.1	9.5	2.5	SEC
1SMA28CAT3	28	31.1	1	45.4	8.8	2.5	SGC
1SMA30CAT3	30	33.3	1	48.4	8.3	2.5	SKC
1SMA33CAT3	33	36.7	1	53.3	7.5	2.5	SMC
1SMA36CAT3	36	40	1	58.1	6.9	2.5	SPC
1SMA40CAT3	40	44.4	1	64.5	6.2	2.5	SFC
1SMA43CAT3	43	47.8	1	69.4	5.8	2.5	STC
1SMA45CAT3	45	50	1	72.2	5.5	2.5	SVC
1SMA48CAT3	48	53.3	1	77.4	5.2	2.5	SXC
1SMA51CAT3	51	56.7	1	82.4	4.9	2.5	SZC
1SMA54CAT3	54	60	1	87.1	4.6	2.5	TEC
1SMA58CAT3	58	64.4	1	93.6	4.3	2.5	TGC
1SMA60CAT3	60	66.7	1	96.8	4.1	2.5	TKC
1SMA64CAT3	64	71.1	1	103.0	3.9	2.5	TMC
1SMA70CAT3	70	77.8	1	113.0	3.5	2.5	TPC
1SMA75CAT3	75	83.3	1	121.0	3.3	2.5	TRC
1SMA78CAT3	78	86.7	1	126.0	3.2	2.5	TTC



# TVS

## Surface Mount Packages (continued)

Table 9. Peak Power Dissipation (600 Watts @ 1 ms Surge – Figure 1) Case 403A–03

 SMB CASE 403A–03 PLASTIC Cathode = Notch		 Figure 1 Surge Current Characteristics					
ELECTRICAL CHARACTERISTICS (T <sub>A</sub> = 25°C unless otherwise noted)							
Reverse Stand-Off V <sub>R</sub> (Volts)(1)	Device(2, 3)	Breakdown Voltage		Maximum Clamping Voltage V <sub>C</sub> @ I <sub>pp</sub> Volts	Peak Pulse Current (See Figure 1) I <sub>pp</sub> Amps	Maximum Reverse Leakage @ V <sub>R</sub> I <sub>R</sub> μA	Device Marking
		V <sub>BR</sub> @ I <sub>T</sub>					
		Volts Min	Pulse mA				
5	<b>1SMB5.0AT3</b>	6.4	10	9.2	65.2	800	KE
6	<b>1SMB6.0AT3</b>	6.67	10	10.3	58.3	800	KG
6.5	1SMB6.5AT3	7.22	10	11.2	53.6	500	KK
7	1SMB7.0AT3	7.78	10	12	50	200	KM
7.5	1SMB7.5AT3	8.33	1	12.9	46.5	100	KP
8	1SMB8.0AT3	8.89	1	13.6	44.1	50	KR
8.5	1SMB8.5AT3	9.44	1	14.4	41.7	10	KT
9	1SMB9.0AT3	10	1	15.4	39	5	KV
10	1SMB10AT3	11.1	1	17	35.3	5	KX
11	1SMB11AT3	12.2	1	18.2	33	5	KZ
12	1SMB12AT3	13.3	1	19.9	30.2	5	LE
13	1SMB13AT3	14.4	1	21.5	27.9	5	LG
14	1SMB14AT3	15.6	1	23.2	25.8	5	LK
15	1SMB15AT3	16.7	1	24.4	24	5	LM
16	1SMB16AT3	17.8	1	26	23.1	5	LP
18	1SMB18AT3	20	1	29.2	20.5	5	LT
20	1SMB20AT3	22.2	1	32.4	18.5	5	LV
22	<b>1SMB22AT3</b>	24.4	1	35.5	16.9	5	LX
24	1SMB24AT3	26.7	1	38.9	15.4	5	LZ
26	1SMB26AT3	28.9	1	42.1	14.2	5	ME
28	1SMB28AT3	31.1	1	45.4	13.2	5	MG
30	1SMB30AT3	33.3	1	48.4	12.4	5	MK
36	1SMB36AT3	40	1	58.1	10.3	5	MP
40	1SMB40AT3	44.4	1	64.5	9.3	5	MR
43	1SMB43AT3	47.8	1	69.4	8.6	5	MT
45	1SMB45AT3	50	1	72.7	8.3	5	MV
48	1SMB48AT3	53.3	1	77.4	7.7	5	MX
51	1SMB51AT3	56.7	1	82.4	7.3	5	MZ
54	1SMB54AT3	60	1	87.1	6.9	5	NE
58	<b>1SMB58AT3</b>	64.4	1	93.6	6.4	5	NG
60	1SMB60AT3	66.7	1	96.8	6.2	5	NK


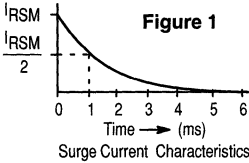
- (1) A transient suppressor is normally selected according to the reverse "Stand Off Voltage" (V<sub>R</sub>) which should be equal to or greater than the DC or continuous peak operating voltage level.  
 (2) T3 suffix designates tape and reel of 2500 units.  
 (3) Bidirectional version available for 1SMB10AT3 thru 1SMB78AT3, electrical characteristics apply in both directions except for V<sub>R</sub>. Use CAT3 suffix.

Devices listed in bold, italic are Motorola preferred devices.

# TVS

## Surface Mount Packages (continued)

Table 9. Peak Power Dissipation (600 Watts @ 1 ms Surge – Figure 1) Case 403A–03 (continued)

<div style="display: flex; justify-content: space-between; align-items: center;"> <div style="text-align: center;">  <p><b>SMB</b> <b>CASE 403A–03</b> <b>PLASTIC</b> <b>Cathode = Notch</b></p> </div> <div style="text-align: center;">  <p><b>Figure 1</b> Surge Current Characteristics</p> </div> </div>							
<b>ELECTRICAL CHARACTERISTICS</b> (T <sub>A</sub> = 25°C unless otherwise noted)							
Reverse Stand-Off V <sub>R</sub> (Volts) <sup>(1)</sup>	Device <sup>(2, 3)</sup>	Breakdown Voltage		Maximum Clamping Voltage V <sub>C</sub> @ I <sub>pp</sub> Volts	Peak Pulse Current (See Figure 1) I <sub>pp</sub> Amps	Maximum Reverse Leakage @ V <sub>R</sub> I <sub>R</sub> μA	Device Marking
		V <sub>BR</sub> @ I <sub>T</sub>					
		Volts Min	Pulse mA				
64	1SMB64AT3	71.1	1	103	5.8	5	NM
70	1SMB70AT3	77.8	1	113	5.3	5	NP
75	1SMB75AT3	83.3	1	121	4.9	5	NR
78	1SMB78AT3	86.7	1	126	4.7	5	NT
85	1SMB85AT3	94.4	1	137	4.4	5	NV
90	1SMB90AT3	100	1	146	4.1	5	NX
100	1SMB100AT3	111	1	162	3.7	5	NZ
110	1SMB110AT3	122	1	177	3.4	5	PE
120	1SMB120AT3	133	1	193	3.1	5	PG
130	1SMB130AT3	144	1	209	2.9	5	PK
150	1SMB150AT3	167	1	243	2.5	5	PM
160	1SMB160AT3	178	1	259	2.3	5	PP
170	1SMB170AT3	189	1	275	2.2	5	PR

(1) A transient suppressor is normally selected according to the reverse "Stand Off Voltage" (V<sub>R</sub>) which should be equal to or greater than the DC or continuous peak operating voltage level.

(2) T3 suffix designates tape and reel of 2500 units.

(3) Bidirectional version available for 1SMB10AT3 thru 1SMB78AT3, electrical characteristics apply in both directions except for V<sub>PI</sub>. Use CAT3 suffix.

# TVS

## Surface Mount Packages (continued)

Table 10. Peak Power Dissipation (600 Watts @ 1 ms Surge – Figure 1) Case 403A–03

ELECTRICAL CHARACTERISTICS (T <sub>A</sub> = 25°C unless otherwise noted) V <sub>F</sub> = 3.5 V Max, I <sub>F</sub> <sup>(5)</sup> = 100 A for all types.										
Device(3, 4)	V <sub>BR</sub> @ I <sub>T</sub> Volts				Working Peak Reverse Voltage V <sub>VRWM</sub> Volts	Maximum Reverse Leakage @ V <sub>VRWM</sub> I <sub>R</sub> μA	Maximum Reverse Surge Current I <sub>RSM</sub> Amps	Maximum Reverse Voltage @ I <sub>RSM</sub> (Clamping Voltage) V <sub>RSM</sub> Volts	Maximum Temperature Coefficient of V <sub>BR</sub> %/°C	Device Marking
	Min	Nom	Max	mA						
<b>P6SMB6.8AT3</b>	<b>6.45</b>	<b>6.8</b>	<b>7.14</b>	<b>10</b>	<b>5.8</b>	<b>1000</b>	<b>57</b>	<b>10.5</b>	<b>0.057</b>	<b>6V8A</b>
<b>P6SMB7.5AT3</b>	<b>7.13</b>	<b>7.5</b>	<b>7.88</b>	<b>10</b>	<b>6.4</b>	<b>500</b>	<b>53</b>	<b>11.3</b>	<b>0.061</b>	<b>7V5A</b>
P6SMB9.1AT3	8.65	9.1	9.55	1	7.78	50	45	13.4	0.068	9V1A
<b>P6SMB10AT3</b>	<b>9.5</b>	<b>10</b>	<b>10.5</b>	<b>1</b>	<b>8.55</b>	<b>10</b>	<b>41</b>	<b>14.5</b>	<b>0.073</b>	<b>10A</b>
P6SMB12AT3	11.4	12	12.6	1	10.2	5	36	16.7	0.078	12A
<b>P6SMB13AT3</b>	<b>12.4</b>	<b>13</b>	<b>13.7</b>	<b>1</b>	<b>11.1</b>	<b>5</b>	<b>33</b>	<b>18.2</b>	<b>0.081</b>	<b>13A</b>
<b>P6SMB15AT3</b>	<b>14.3</b>	<b>15</b>	<b>15.8</b>	<b>1</b>	<b>12.8</b>	<b>5</b>	<b>28</b>	<b>21.2</b>	<b>0.084</b>	<b>15A</b>
<b>P6SMB16AT3</b>	<b>15.2</b>	<b>16</b>	<b>16.8</b>	<b>1</b>	<b>13.6</b>	<b>5</b>	<b>27</b>	<b>22.5</b>	<b>0.086</b>	<b>16A</b>
<b>P6SMB18AT3</b>	<b>17.1</b>	<b>18</b>	<b>18.9</b>	<b>1</b>	<b>15.3</b>	<b>5</b>	<b>24</b>	<b>25.2</b>	<b>0.088</b>	<b>18A</b>
<b>P6SMB20AT3</b>	<b>19</b>	<b>20</b>	<b>21</b>	<b>1</b>	<b>17.1</b>	<b>5</b>	<b>22</b>	<b>27.7</b>	<b>0.09</b>	<b>20A</b>
<b>P6SMB22AT3</b>	<b>20.9</b>	<b>22</b>	<b>23.1</b>	<b>1</b>	<b>18.8</b>	<b>5</b>	<b>20</b>	<b>30.6</b>	<b>0.092</b>	<b>22A</b>
P6SMB24AT3	22.8	24	25.2	1	20.5	5	18	33.2	0.094	24A
<b>P6SMB27AT3</b>	<b>25.7</b>	<b>27</b>	<b>28.4</b>	<b>1</b>	<b>23.1</b>	<b>5</b>	<b>16</b>	<b>37.5</b>	<b>0.096</b>	<b>27A</b>
<b>P6SMB30AT3</b>	<b>28.5</b>	<b>30</b>	<b>31.5</b>	<b>1</b>	<b>25.6</b>	<b>5</b>	<b>14.4</b>	<b>41.4</b>	<b>0.097</b>	<b>30A</b>
P6SMB33AT3	31.4	33	34.7	1	28.2	5	13.2	45.7	0.098	33A
<b>P6SMB36AT3</b>	<b>34.2</b>	<b>36</b>	<b>37.8</b>	<b>1</b>	<b>30.8</b>	<b>5</b>	<b>12</b>	<b>49.9</b>	<b>0.099</b>	<b>36A</b>
<b>P6SMB39AT3</b>	<b>37.1</b>	<b>39</b>	<b>41</b>	<b>1</b>	<b>33.3</b>	<b>5</b>	<b>11.2</b>	<b>53.9</b>	<b>0.1</b>	<b>39A</b>
P6SMB47AT3	44.7	47	49.4	1	40.2	5	9.3	64.8	0.101	47A
<b>P6SMB51AT3</b>	<b>48.5</b>	<b>51</b>	<b>53.6</b>	<b>1</b>	<b>43.6</b>	<b>5</b>	<b>8.6</b>	<b>70.1</b>	<b>0.102</b>	<b>51A</b>
P6SMB56AT3	37.1	39	41	1	33.3	5	11.2	53.9	0.1	39A
P6SMB62AT3	58.9	62	65.1	1	53	5	7.1	85	0.104	62A
P6SMB68AT3	64.6	68	71.4	1	58.1	5	6.5	92	0.104	68A
P6SMB82AT3	77.9	82	86.1	1	70.1	5	5.3	113	0.105	82A
P6SMB91AT3	86.5	91	95.5	1	77.8	5	4.8	125	0.106	91A
P6SMB100AT3	95	100	105	1	85.5	5	4.4	137	0.106	100A
P6SMB110AT3	105	110	116	1	94	5	4	152	0.107	110A
P6SMB120AT3	114	120	126	1	102	5	3	165	0.107	120A
P6SMB150AT3	143	150	158	1	128	5	2.9	207	0.108	150A
<b>P6SMB160AT3</b>	<b>152</b>	<b>160</b>	<b>168</b>	<b>1</b>	<b>136</b>	<b>5</b>	<b>2.7</b>	<b>219</b>	<b>0.108</b>	<b>160A</b>
P6SMB170AT3	162	170	179	1	145	5	2.6	234	0.108	170A
P6SMB180AT3	171	180	189	1	154	5	2.4	246	0.108	180A
P6SMB200AT3	190	200	210	1	171	5	2.2	274	0.108	200A

(1) Breakdown voltage tolerance is ±5% for A suffix.

(2) V<sub>BR</sub> measured at pulse test current I<sub>T</sub> at an ambient temperature of 25°C.

(3) T3 suffix designates tape and reel of 2500 units.

(4) Bidirectional version available for P6SMB12AT3 thru P6SMB91AT3. Electrical characteristics apply in both directional except for V<sub>F</sub>. Use CAT3 suffix.

(5) 1/2 sine wave (or equivalent square wave), PW = 8.3 ms, duty cycle = 4 pulses per minute maximum.

Devices listed in bold, italic are Motorola preferred devices.

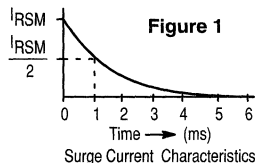
# TVS

## Surface Mount Packages (continued)

Table 11. Peak Power Dissipation (1500 Watts @ 1 ms Surge – Figure 1) Case 403–03



SMC  
CASE 403–03  
PLASTIC  
Cathode = Notch



### ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25°C unless otherwise noted)

Device(1)	Reverse Stand-Off Voltage V <sub>R</sub> Volts(2)	Breakdown Voltage(3)		Maximum Clamping Voltage V <sub>C</sub> @ I <sub>pp</sub> Volts	Peak Pulse Current (See Figure 1) I <sub>pp</sub> Amps	Maximum Reverse Leakage @ V <sub>R</sub> I <sub>R</sub> μA	Device Marking
		V <sub>BR</sub> @ I <sub>T</sub>					
		Volts Min	mA				
1SMC5.0AT3	5.0	6.40	10	9.2	163.0	1000	GDE
1SMC6.0AT3	6.0	6.67	10	10.3	145.6	1000	GDG
1SMC6.5AT3	6.5	7.22	10	11.2	133.9	500	GDK
1SMC7.0AT3	7.0	7.78	10	12.0	125.0	200	GDM
1SMC7.5AT3	7.5	8.33	1.0	12.9	116.3	100	GDP
1SMC8.0AT3	8.0	8.89	1.0	13.6	110.3	50	GDR
1SMC8.5AT3	8.5	9.44	1.0	14.4	104.2	20	GDT
1SMC9.0AT3	9.0	10.0	1.0	15.4	97.4	10	GDV
1SMC10AT3	10	11.1	1.0	17.0	88.2	5.0	GDY
1SMC11AT3	11	12.2	1.0	18.2	82.4	5.0	GDZ
1SMC12AT3	12	13.3	1.0	19.9	75.3	5.0	GEE
1SMC13AT3	13	14.4	1.0	21.5	69.7	5.0	GEG
1SMC14AT3	14	15.6	1.0	23.2	64.7	5.0	GEK
1SMC15AT3	15	16.7	1.0	24.4	61.5	5.0	GEM
1SMC16AT3	16	17.8	1.0	26.0	57.7	5.0	GEP
1SMC17AT3	17	18.9	1.0	27.6	53.3	5.0	GER
1SMC18AT3	18	20.0	1.0	29.2	51.4	5.0	GET
1SMC20AT3	20	22.2	1.0	32.4	46.3	5.0	GEV
1SMC22AT3	22	24.4	1.0	35.5	42.2	5.0	GEX
1SMC24AT3	24	26.7	1.0	38.9	38.6	5.0	GEZ
1SMC26AT3	26	28.9	1.0	42.1	35.6	5.0	GFE
1SMC28AT3	28	31.1	1.0	45.4	33.0	5.0	GFG
1SMC30AT3	30	33.3	1.0	48.4	31.0	5.0	GFK
1SMC33AT3	33	36.7	1.0	53.3	28.1	5.0	GFM
1SMC36AT3	36	40.0	1.0	58.1	25.8	5.0	GFP
1SMC40AT3	40	44.4	1.0	64.5	23.2	5.0	GFR
1SMC43AT3	43	47.8	1.0	69.4	21.6	5.0	GFT
1SMC45AT3	45	50.0	1.0	72.7	20.6	5.0	GFV
1SMC48AT3	48	53.3	1.0	77.4	19.4	5.0	GFX
1SMC51AT3	51	56.7	1.0	82.4	18.2	5.0	GFZ
1SMC54AT3	54	60.0	1.0	87.1	17.2	5.0	GGE
<b>1SMC58AT3</b>	<b>58</b>	<b>64.4</b>	<b>1.0</b>	<b>93.6</b>	<b>16.0</b>	<b>5.0</b>	<b>GGG</b>
1SMC60AT3	60	66.7	1.0	96.8	15.5	5.0	GGK
1SMC64AT3	64	71.1	1.0	103	14.6	5.0	GGM
1SMC70AT3	70	77.8	1.0	113	13.3	5.0	GGP
1SMC75AT3	75	83.3	1.0	121	12.4	5.0	GGR
1SMC78AT3	78	86.7	1.0	126	11.4	5.0	GGT

(1) T3 suffix designates tape and reel of 2500 units.

(2) A transient suppressor is normally selected according to the reverse "Stand Off Voltage" (V<sub>R</sub>) which should be equal to or greater than the DC or continuous peak operating voltage level.

(3) V<sub>BR</sub> measured at pulse test current I<sub>T</sub> at an ambient temperature of 25°C.

Devices listed in bold, italic are Motorola preferred devices.

# TVS

## Surface Mount Packages (continued)

Table 12. Peak Power Dissipation (1500 Watts @ 1 ms Surge – Figure 1) Case 403-03

ELECTRICAL CHARACTERISTICS (T <sub>A</sub> = 25°C unless otherwise noted) V <sub>F</sub> = 3.5 V Max, I <sub>F</sub> <sup>(3)</sup> = 100 A for all types.											
Device(1)	Breakdown Voltage(2)				Working Peak Reverse Voltage V <sub>PRWM</sub> Volts	Maximum Reverse Leakage @ V <sub>PRWM</sub> I <sub>R</sub> μA	Maximum Reverse Surge Current I <sub>RSM</sub> Amps	Maximum Reverse Voltage @ I <sub>RSM</sub> (Clamping Voltage) V <sub>RSM</sub> Volts	Maximum Temperature Coefficient of V <sub>BR</sub> %/°C	Device Marking	
	V <sub>BR</sub> @ I <sub>T</sub> Volts										
	Min	Nom	Max	mA							
1.5SMC6.8AT3	6.45	6.8	7.14	10	5.8	1000	143	10.5	0.057	6V8A	
1.5SMC8.2AT3	7.79	8.2	8.61	10	7.02	200	124	12.1	0.065	8V2A	
1.5SMC9.1AT3	8.65	9.1	9.55	1	7.78	50	112	13.4	0.068	9V1A	
1.5SMC10AT3	9.5	10	10.5	1	8.55	10	103	14.5	0.073	10A	
1.5SMC11AT3	10.5	11	11.6	1	9.4	5	96	15.6	0.075	11A	
1.5SMC12AT3	11.4	12	12.6	1	10.2	5	90	16.7	0.078	12A	
1.5SMC13AT3	12.4	13	13.7	1	11.1	5	82	18.2	0.081	13A	
<b>1.5SMC15AT3</b>	<b>14.3</b>	<b>15</b>	<b>15.8</b>	<b>1</b>	<b>12.8</b>	<b>5</b>	<b>71</b>	<b>21.2</b>	<b>0.084</b>	<b>15A</b>	
1.5SMC18AT3	17.1	18	18.9	1	15.3	5	59.5	25.2	0.088	18A	
1.5SMC22AT3	20.9	22	23.1	1	18.8	5	49	30.6	0.092	22A	
<b>1.5SMC24AT3</b>	<b>22.8</b>	<b>24</b>	<b>25.2</b>	<b>1</b>	<b>20.5</b>	<b>5</b>	<b>45</b>	<b>33.2</b>	<b>0.094</b>	<b>24A</b>	
1.5SMC27AT3	25.7	27	28.4	1	23.1	5	40	37.5	0.096	27A	
1.5SMC30AT3	28.5	30	31.5	1	25.6	5	36	41.4	0.097	30A	
<b>1.5SMC33AT3</b>	<b>31.4</b>	<b>33</b>	<b>34.7</b>	<b>1</b>	<b>28.2</b>	<b>5</b>	<b>33</b>	<b>45.7</b>	<b>0.098</b>	<b>33A</b>	
<b>1.5SMC36AT3</b>	<b>34.2</b>	<b>36</b>	<b>37.8</b>	<b>1</b>	<b>30.8</b>	<b>5</b>	<b>30</b>	<b>49.9</b>	<b>0.099</b>	<b>36A</b>	
<b>1.5SMC39AT3</b>	<b>37.1</b>	<b>39</b>	<b>41</b>	<b>1</b>	<b>33.3</b>	<b>5</b>	<b>28</b>	<b>53.9</b>	<b>0.1</b>	<b>39A</b>	
<b>1.5SMC43AT3</b>	<b>40.9</b>	<b>43</b>	<b>45.2</b>	<b>1</b>	<b>36.8</b>	<b>5</b>	<b>25.3</b>	<b>59.3</b>	<b>0.101</b>	<b>43A</b>	
<b>1.5SMC47AT3</b>	<b>44.7</b>	<b>47</b>	<b>49.4</b>	<b>1</b>	<b>40.2</b>	<b>5</b>	<b>23.2</b>	<b>64.8</b>	<b>0.101</b>	<b>47A</b>	
1.5SMC51AT3	48.5	51	53.6	1	43.6	5	21.4	70.1	0.102	51A	
1.5SMC56AT3	53.2	56	58.8	1	47.8	5	19.5	77	0.103	56A	
1.5SMC62AT3	58.9	62	65.1	1	53	5	17.7	85	0.104	62A	
1.5SMC68AT3	64.6	68	71.4	1	58.1	5	16.3	92	0.104	68A	
<b>1.5SMC75AT3</b>	<b>71.3</b>	<b>75</b>	<b>78.8</b>	<b>1</b>	<b>64.1</b>	<b>5</b>	<b>14.6</b>	<b>103</b>	<b>0.105</b>	<b>75A</b>	
1.5SMC82AT3	77.9	82	86.1	1	70.1	5	13.3	113	0.105	82A	
1.5SMC91AT3	86.5	91	95.5	1	77.8	5	12	125	0.106	91A	

(1) T3 suffix designates tape and reel of 2500 units.

(2) V<sub>BR</sub> measured at pulse test current I<sub>T</sub> at an ambient temperature of 25°C.

(3) 1/2 sine wave (or equivalent square wave), PW = 8.3 ms, duty cycle = 4 pulses per minute maximum.

Devices listed in bold, italic are Motorola preferred devices.

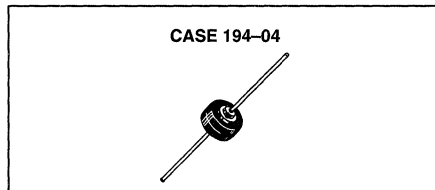
# TVS

## Overvoltage Transient Suppressors

**Table 13. Overvoltage Transient Suppressors**

Overvoltage transient suppressors are designed for protection against over-voltage conditions in the auto electrical system including the "LOAD DUMP" phenomenon that occurs when the battery open circuits while the car is running.

OVERVOLTAGE TRANSIENT SUPPRESSOR	
	<b>CASE 194-04</b> <b>MR2535L</b>
<b>VRRM (Volts)</b>	20
<b>I<sub>O</sub> (Amp)</b>	35
<b>V(BR) (Volts)</b>	24-32
<b>I<sub>RSM</sub><sup>(30)</sup> (Amp)</b>	110
<b>T<sub>C</sub> @ Rated I<sub>O</sub> (°C)</b>	150
<b>T (°C)</b>	175



<sup>(30)</sup> Time constant = 10 ms, duty cycle ≤ 1%, T<sub>C</sub> = 25°C.

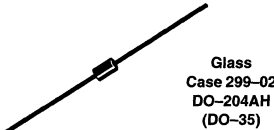
Note: MR2535L is considered part of the rectifier product portfolio.

Devices listed in bold, italic are Motorola preferred devices.

# Zener Diodes

## Voltage Regulator Diodes

Table 14. Axial Leaded for Through-hole Designs – 500 mW

Nominal Zener Breakdown Voltage	500 mW Low Level Cathode = Polarity Band	500 mW Cathode = Polarity Band			500 mW Low Level Cathode = Polarity Band	500 mW Cathode = Polarity Band
(*Note 1)	(*Note 2)	(*Note 3)	(*Note 4)	(*Note 5)	(*Note 6)	(*Note 7)
Volts						
1.8	1N4678				MZ4614	
2.0	1N4679				MZ4615	
2.2					MZ4616	
2.4	1N4681	1N5221B	1N5985B	BZX79C2V4RL	MZ4617	
2.5		1N5222B				
2.7	1N4682	1N5223B		BZX79C2V7RL	MZ4618	
2.8		1N5224B				
3.0	1N4683	1N5225B	1N5987B	BZX79C3V0RL	MZ4619	
3.3	1N4684	<b>1N5226B</b>	1N5988B	BZX79C3V3RL	MZ4620	
3.6	1N4685	1N5227B	1N5989B	BZX79C3V6RL		
3.9	1N4686	<b>1N5228B</b>	1N5990B		MZ4622	MZ5520B
4.3	1N4687	1N5229B	1N5991B	BZX79C4V3RL	MZ4623	MZ5521B
4.7	<b>1N4688</b>	1N5230B	1N5992B	BZX79C4V7RL	MZ4624	
5.1	1N4689	<b>1N5231B</b>	<b>1N5993B</b>	BZX79C5V1RL	MZ4625	MZ5523B
5.6	1N4690	<b>1N5232B</b>	<b>1N5994B</b>	BZX79C5V6RL	MZ4626	MZ5524B
6.0		1N5233B				
6.2	1N4691	<b>1N5234B</b>	1N5995B	BZX79C6V2RL	MZ4627	MZ5525B
6.8	1N4692	<b>1N5235B</b>	1N5996B	BZX79C6V8RL	MZ4099	
7.5	1N4693	1N5236B	1N5997B			MZ5527B
8.2	1N4694	<b>1N5237B</b>	<b>1N5998B</b>	BZX79C8V2RL	MZ4101	
8.7	1N4695	1N5238B				
9.1	1N4696	1N5239B	1N5999B	BZX79C9V1RL		MZ5529B
10	1N4697	<b>1N5240B</b>	1N6000B		MZ4104	
11	1N4698	1N5241B				
12	1N4699	<b>1N5242B</b>	1N6002B	BZX79C12RL		
13	1N4700	1N5243B	1N6003B			
14		1N5244B				
15	1N4702	<b>1N5245B</b>	1N6004B	BZX79C15RL		
16	1N4703	<b>1N5246B</b>		BZX79C16RL		
17	1N4704	1N5247B				
18	1N4705	1N5248B				

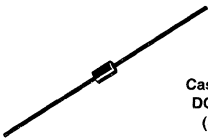
\*See Notes on page 5.2–23.

Devices listed in bold, italic are Motorola preferred devices.

# Zener Diodes

## Voltage Regulator Diodes (continued)

Table 14. Axial Leaded for Through-hole Designs – 500 mW (continued)

Nominal Zener Breakdown Voltage	500 mW Low Level Cathode = Polarity Band	500 mW Cathode = Polarity Band			500 mW Low Level Cathode = Polarity Band	500 mW Cathode = Polarity Band
		(*Note 3)	(*Note 4)	(*Note 5)		
(*Note 1)	(*Note 2)	(*Note 3)	(*Note 4)	(*Note 5)	(*Note 6)	(*Note 7)
Volts	 <p>Glass Case 299-02 DO-204AH (DO-35)</p>					
19		1N5249B				
20	1N4707	<b>1N5250B</b>	1N6007B			
22	1N4708	1N5251B				
24		1N5252B				
25		1N5253B				
27		1N5254B				
28		1N5255B				
30		1N5256B				
33		1N5257B		BZX79C33RL		
36		1N5258B				
39		1N5259B				
43		1N5260B				
47		1N5261B				
51		1N5262B				
56		1N5263B				
60		1N5264B				
62		1N5265B				
68		1N5266B				
75		1N5267B				
82		1N5268B				
87		1N5269B				
91		1N5270B				
100		1N5271B				
110		1N5272B				
120		1N5273B				
130		1N5274B				
140		1N5275B				
150		1N5276B				
160						
170		1N5278B				
180		1N5279B				
190		1N5280B				
200		1N5281B				
220						
240						
270						
300						
330						
360						
400						

\*See Notes on page 5.2-23.


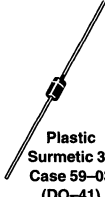


Devices listed in bold, italic are Motorola preferred devices.



# Zener Diodes

## Voltage Regulator Diodes (continued)

Table 15. Axial Leaded for Through-hole Designs – 1, 1.3, 1.5, 3 and 5 Watt

Nominal Zener Breakdown Voltage	1 Watt		1.5 Watt	3 Watt	5 Watt	
	Cathode = Polarity Band		Cathode = Polarity Band	Cathode = Polarity Band	Cathode = Polarity Band	
(*Note 1)	(*Note 8)	(*Note 9)	(*Note 10)	(*Note 11)	(*Note 12)	
Volts	 Glass Case 59-03 (DO-41)	 Plastic Surmetic 30 Case 59-03 (DO-41)	 Plastic Surmetic 30 Case 59-03 (DO-41)		 Plastic Surmetic 40 Case 17-02	
3.3	1N4728A	MZP4728A	1N5913B		1N5333B	
3.6	1N4729A	MZP4729A	1N5914B		1N5334B	
3.9	1N4730A			<b>3EZ4.3D5</b>	1N5335B	
4.3	1N4731A		1N5916B		1N5336B	
4.7	1N4732A		1N5917B		1N5337B	
5.1	<b>1N4733A</b>		1N5918B		1N5338B	
5.6	<b>1N4734A</b>	MZP4734A	1N5919B		1N5339B	
6.0					1N5340B	
6.2	<b>1N4735A</b>	MZP4735A	<b>1N5920B</b>		1N5341B	
6.8	<b>1N4736A</b>		1N5921B		1N5342B	
7.5	1N4737A	MZP4737A	1N5922B		3EZ7.5D5	1N5343B
8.2	<b>1N4738A</b>	MZP4738A	1N5923B		3EZ8.2D5	1N5344B
8.7					1N5345B	
9.1	1N4739A		1N5924B	3EZ9.1D5	1N5346B	
10	<b>1N4740A</b>	MZP4740A	1N5925B	3EZ10D5	1N5347B	
11	<b>1N4741A</b>	MZP4741A	1N5926B	3EZ11D5	1N5348B	
12	<b>1N4742A</b>		1N5927B		1N5349B	
13	1N4743A			3EZ13D5	1N5350B	
14				3EZ14D5	1N5351B	
15	<b>1N4744A</b>	MZP4744A	<b>1N5929B</b>		1N5352B	
16	<b>1N4745A</b>	MZP4745A	1N5930B		1N5353B	
17					1N5354B	
18	<b>1N4746A</b>	<b>MZP4746A</b>	1N5931B		1N5355B	
19				3EZ19D5	1N5356B	
20	<b>1N4747A</b>		1N5932B		1N5357B	
22	<b>1N4748A</b>		1N5933B	3EZ22D5	1N5358B	
24	<b>1N4749A</b>	<b>MZP4749A</b>	1N5934B		1N5359B	
25					1N5360B	
27	<b>1N4750A</b>	MZP4750A	1N5935B	3EZ27D5	1N5361B	
28				3EZ28D5	1N5362B	
30	<b>1N4751A</b>	<b>MZP4751A</b>	1N5936B		1N5363B	
33	<b>1N4752A</b>	MZP4752A	1N5937B	3EZ33D5	1N5364B	
36	1N4753A	MZP4753A	1N5938B	3EZ36D5	1N5365B	
39	1N4754A		1N5939B		1N5366B	
43	1N4755A			3EZ43D5	1N5367B	
47	1N4756A		1N5941B	3EZ47D5	1N5368B	
51	1N4757A				1N5369B	
56	1N4758A		1N5943B	3EZ56D5	1N5370B	
60					1N5371B	
62	1N4759A				1N5372B	
68	1N4760A			3EZ68D5	1N5373B	





\*See Notes on page 5.2-23.

Devices listed in bold, italic are Motorola preferred devices.

# Zener Diodes

## Voltage Regulator Diodes (continued)

Table 15. Axial Leaded for Through-hole Designs – 1, 1.3, 1.5, 3 and 5 Watt (continued)

Nominal Zener Breakdown Voltage	1 Watt		1.5 Watt	3 Watt	5 Watt
	Cathode = Polarity Band		Cathode = Polarity Band	Cathode = Polarity Band	Cathode = Polarity Band
(*Note 1)	(*Note 8)	(*Note 9)	(*Note 10)	(*Note 11)	(*Note 12)
Volts	 Glass Case 59-03 (DO-41)	 Plastic Surmetic 30 Case 59-03 (DO-41)	 Plastic Surmetic 30 Case 59-03 (DO-41)	 Plastic Surmetic 40 Case 17-02	
75	1N4761A		1N5946B	3EZ75D5	1N5374B
82	1N4762A				1N5375B
87					1N5376B
91	1N4763A			3EZ91D5	1N5377B
100	1N4764A				1N5378B
110				3EZ110D5	1N5379B
120			1N5951B	3EZ120D5	1N5380B
130				3EZ130D5	1N5381B
140				3EZ140D5	1N5382B
150			1N5953B		1N5383B
160			1N5954B	3EZ160D5	1N5384B
170					1N5385B
180			<b>1N5955B</b>		1N5386B
190				3EZ190D5	1N5387B
200			1N5956B	3EZ200D5	1N5388B
220				3EZ220D5	
240				3EZ240D5	
270					
300					
330				3EZ330D5	
360					
400				3EZ400D5	

\*See Notes on page 5.2-23.

Devices listed in bold, italic are Motorola preferred devices.

# Zener Diodes

## Notes — Axial Leaded Chart

1. Zener Voltage is the key parameter for each device type. It is specified at a particular test current applied at either thermal equilibrium (T.E.) or pulse test condition. The voltage tolerance for the device types listed is, in general,  $\pm 5\%$ ; however, for some series, the voltage tolerance varies from device type to device type over a range of  $\pm(5$  to  $8.5)\%$ . Consult the complete data sheet to determine the exact test conditions and minimum/maximum limits for the zener voltage. Consult Application Note AN924 regarding measurement of Zener Voltage (pulse versus thermal equilibrium).

Power Ratings represent the capability of the case size listed as supplied by Motorola. These ratings may be higher than the JEDEC registration and/or the same device types supplied by other manufacturers. (On tight tolerance devices, please consult factory on availability.)





### $V_Z$ Test Conditions and Tolerances

- |   |  |
|---|--|
| 2. 1N4678 Series                                    | $I_{ZT} = 50 \mu\text{A}$ (T.E.).<br>No suffix = $\pm 5\%$ .<br>Also has delta $V_Z$ parameter and limit.  |
| 3. 1N5221B–42B<br>1N5243B–81B                       | $I_{ZT} = 20 \text{ mA}$ (T.E.).<br>$I_{ZT}$ @ approximately 125 mW point (T.E.).<br>B suffix = $\pm 5\%$ .  |
| 4. 1N5985B–1N6007B                                  | $I_{ZT} = 5 \text{ mA}$ (T.E.).<br>B suffix = $\pm 5\%$ .  |
| 5. BZX79C2V4–C16RL<br>BZX79C33                      | $I_{ZT} = 5 \text{ mA}$ (pulse).<br>$I_{ZT} = 2 \text{ mA}$ (pulse).<br>C indicates $\pm(5$ to $8.5)\%$ depending on type number.  |
| 6. MZ4614–27<br>MZ4099–4104                         | $I_{ZT} = 250 \mu\text{A}$ (T.E.).<br>$I_{ZT} = 250 \mu\text{A}$ (T.E.).<br>Tolerance is $\pm 5\%$ .   |
| 7. MZ5520B–21B<br>MZ5523B<br>MZ5524B<br>MZ5525B–29B | $I_{ZT} = 20 \text{ mA}$ (T.E.).<br>$I_{ZT} = 5 \text{ mA}$ (T.E.).<br>$I_{ZT} = 3 \text{ mA}$ (T.E.).<br>$I_{ZT} = 1 \text{ mA}$ (T.E.).<br>Tolerance is $\pm 5\%$ .<br>Also has delta $V_Z$ parameter and limit. |
| 8. 1N4728A–64A                                      | $I_{ZT}$ @ approximately 250 mW point (T.E.).<br>A suffix = $\pm 5\%$ .  |
| 9. MZP4728A–53A                                     | $I_{ZT}$ @ approximately 250 mW point (T.E.).<br>MZP Series A suffix = $\pm 5\%$ .   |
| 10. 1N5913B–56B                                     | $I_{ZT}$ @ approximately 375 mW point (T.E.).<br>B suffix = $\pm 5\%$ .  |
| 11. 3EZ4.3D5–400D5                                  | $I_{ZT}$ @ approximately 750 mW point (pulse).<br>Suffix 5 = $\pm 5\%$ .   |
| 12. 1N5333B–88B                                     | $I_{ZT}$ varies from 0.9 to 1.5 W point depending on type number (pulse).<br>B suffix = $\pm 5\%$ .<br>Also has delta $V_Z$ parameter and limit.   |

# Zener Diodes

## Voltage Regulator Diodes (continued)

Table 16. Surface Mount Packages

Nominal Zener Breakdown Voltage	225 mW Surface Mount		500 mW Surface Mount	500 mW Low Level Surface Mount	500 mW Surface Mount	1.5 Watt Surface Mount	3 Watt Surface Mount
	SOT-23		SOD-123	SOD-123	SOD-123	SMA	SMB
(*Note 1)	(*Note 2)	(*Note 3)	(*Note 4)	(*Note 5)	(*Note 6)	(*Note 7)	(*Note 8)
Volts	 Anode <span style="margin-left: 100px;">Cathode</span> No Connection Plastic Case 318-08 TO-236AB		 Plastic Case 425-04, Style 1			 Plastic Case 403B-01	 Plastic Case 403A-03 Cathode = Notch
1.8				MMSZ4678T1			
2.0				MMSZ4679T1			
2.2				<b>MMSZ4680T1</b>			
2.4	BZX84C2V4LT1	MMBZ5221BLT1	MMSZ2V4T1	MMSZ4681T1	<b>MMSZ5221BT1</b>		
2.5		MMBZ5222BLT1			<b>MMSZ5222BT1</b>		
2.7	BZX84C2V7LT1	MMBZ5223BLT1	MMSZ2V7T1	MMSZ4682T1	MMSZ5223BT1		
2.8		MMBZ5224BLT1			MMSZ5224BT1		
3.0	BZX84C3V0LT1	MMBZ5225BLT1	MMSZ3V0T1	MMSZ4683T1	<b>MMSZ5225BT1</b>		
3.3	BZX84C3V3LT1	MMBZ5226BLT1	MMSZ3V3T1	MMSZ4684T1	MMSZ5226BT1	1SMA5913BT3	1SMB5913BT3
3.6	BZX84C3V6LT1	MMBZ5227BLT1	MMSZ3V6T1	<b>MMSZ4685T1</b>	MMSZ5227BT1	1SMA5914BT3	
3.9	BZX84C3V9LT1	<b>MMBZ5228BLT1</b>	MMSZ3V9T1	MMSZ4686T1	MMSZ5228BT1	1SMA5915BT3	1SMB5915BT3
4.3	BZX84C4V3LT1	MMBZ5229BLT1	MMSZ4V3T1	MMSZ4687T1	<b>MMSZ5229BT1</b>	1SMA5916BT3	1SMB5916BT3
4.7	<b>BZX84C4V7LT1</b>	MMBZ5230BLT1	MMSZ4V7T1	<b>MMSZ4688T1</b>	<b>MMSZ5230BT1</b>	1SMA5917BT3	1SMB5917BT3
5.1	<b>BZX84C5V1LT1</b>	<b>MMBZ5231BLT1</b>	<b>MMSZ5V1T1</b>	<b>MMSZ4689T1</b>	<b>MMSZ5231BT1</b>	1SMA5918BT3	1SMB5918BT3
5.6	<b>BZX84C5V6LT1</b>	<b>MMBZ5232BLT1</b>	<b>MMSZ5V6T1</b>	<b>MMSZ4690T1</b>	<b>MMSZ5232BT1</b>	1SMA5919BT3	1SMB5919BT3
6.0		MMBZ5233BLT1			MMSZ5233BT1		
6.2	<b>BZX84C6V2LT1</b>	<b>MMBZ5234BLT1</b>	<b>MMSZ6V2T1</b>	MMSZ4691T1	<b>MMSZ5234BT1</b>	1SMA5920BT3	1SMB5920BT3
6.8	BZX84C6V8LT1	<b>MMBZ5235BLT1</b>	MMSZ6V8T1	MMSZ4692T1	<b>MMSZ5235BT1</b>	1SMA5921BT3	1SMB5921BT3
7.5	BZX84C7V5LT1	MMBZ5236BLT1	MMSZ7V5T1	MMSZ4693T1	MMSZ5236BT1	1SMA5922BT3	1SMB5922BT3
8.2	BZX84C8V2LT1	MMBZ5237BLT1	MMSZ8V2T1	MMSZ4694T1	MMSZ5237BT1	1SMA5923BT3	1SMB5923BT3
8.7		MMBZ5238BLT1		MMSZ4695T1	MMSZ5238BT1		
9.1	BZX84C9V1LT1	MMBZ5239BLT1	MMSZ9V1T1	MMSZ4696T1	MMSZ5239BT1	1SMA5924BT3	1SMB5924BT3
10	BZX84C10LT1	<b>MMBZ5240BLT1</b>	MMSZ10T1	MMSZ4697T1	<b>MMSZ5240BT1</b>	1SMA5925BT3	1SMB5925BT3
11	BZX84C11LT1	MMBZ5241BLT1	MMSZ11T1	MMSZ4698T1	MMSZ5241BT1	1SMA5926BT3	1SMB5926BT3
12	<b>BZX84C12LT1</b>	<b>MMBZ5242BLT1</b>	MMSZ12T1	MMSZ4699T1	<b>MMSZ5242BT1</b>	1SMA5927BT3	1SMB5927BT3
13	BZX84C13LT1	MMBZ5243BLT1	MMSZ13T1	MMSZ4700T1	MMSZ5243BT1	1SMA5928BT3	1SMB5928BT3
14		MMBZ5244BLT1		MMSZ4701T1	MMSZ5244BT1		
15	BZX84C15LT1	<b>MMBZ5245BLT1</b>	MMSZ15T1	MMSZ4702T1	<b>MMSZ5245BT1</b>	1SMA5929BT3	1SMB5929BT3
16	BZX84C16LT1	MMBZ5246BLT1	MMSZ16T1	MMSZ4703T1	<b>MMSZ5246BT1</b>	1SMA5930BT3	1SMB5930BT3
17		MMBZ5247BLT1		MMSZ4704T1	MMSZ5247BT1		
18	<b>BZX84C18LT1</b>	<b>MMBZ5248BLT1</b>	<b>MMSZ18T1</b>	MMSZ4705T1	<b>MMSZ5248BT1</b>	1SMA5931BT3	1SMB5931BT3
19		MMBZ5249BLT1		MMSZ4706T1	MMSZ5249BT1		
20	BZX84C20LT1	<b>MMBZ5250BLT1</b>	MMSZ20T1	MMSZ4707T1	<b>MMSZ5250BT1</b>	1SMA5932BT3	1SMB5932BT3
22	BZX84C22LT1	MMBZ5251BLT1	MMSZ22T1	MMSZ4708T1	MMSZ5251BT1	1SMA5933BT3	1SMB5933BT3
24	BZX84C24LT1	MMBZ5252BLT1	MMSZ24T1	MMSZ4709T1	<b>MMSZ5252BT1</b>	1SMA5934BT3	1SMB5934BT3
25				MMSZ4710T1	MMSZ5253BT1		
27	BZX84C27LT1	<b>MMBZ5254BLT1</b>	MMSZ27T1	MMSZ4711T1	MMSZ5254BT1	1SMA5935BT3	1SMB5935BT3






\*See Notes page 5.2-26.

Devices listed in bold, italic are Motorola preferred devices.

# Zener Diodes

## Voltage Regulator Diodes (continued)

Table 16. Surface Mount Packages (continued)

Nominal Zener Breakdown Voltage	225 mW Surface Mount		500 mW Surface Mount	500 mW Low Level Surface Mount	500 mW Surface Mount	1.5 Watt Surface Mount	3 Watt Surface Mount
	SOT-23		SOD-123	SOD-123	SOD-123	SMA	SMB
(*Note 1)	(*Note 2)	(*Note 3)	(*Note 4)	(*Note 5)	(*Note 6)	(*Note 7)	(*Note 8)
Volts	 Anode  Cathode No Connection Plastic Case 318-08 TO-236AB		 Plastic Case 425-04, Style 1		 Plastic Case 403B-01	 Plastic Case 403A-03 Cathode = Notch	
28		MMBZ5255BLT1		MMSZ4712T1	MMSZ5255BT1		
30	BZX84C30LT1	MMBZ5256BLT1	MMSZ30T1	MMSZ4713T1	<b>MMSZ5256BT1</b>	1SMA5936BT3	1SMB5936BT3
33	BZX84C33LT1	<b>MMBZ5257BLT1</b>	MMSZ33T1	MMSZ4714T1	MMSZ5257BT1	1SMA5937BT3	1SMB5937BT3
36	BZX84C36LT1	MMBZ5258BLT1	MMSZ36T1	MMSZ4715T1	MMSZ5258BT1	1SMA5938BT3	1SMB5938BT3
39	BZX84C39LT1	MMBZ5259BLT1	<b>MMSZ39T1</b>	MMSZ4716T1	MMSZ5259BT1	1SMA5939BT3	1SMB5939BT3
43	BZX84C43LT1	MMBZ5260BLT1	MMSZ43T1	MMSZ4717T1	MMSZ5260BT1	1SMA5940BT3	1SMB5940BT3
47	BZX84C47LT1	MMBZ5261BLT1	MMSZ47T1		<b>MMSZ5261BT1</b>	1SMA5941BT3	1SMB5941BT3
51	BZX84C51LT1	MMBZ5262BLT1	MMSZ51T1		MMSZ5262BT1	1SMA5942BT3	1SMB5942BT3
56	BZX84C56LT1	MMBZ5263BLT1	MMSZ56T1		MMSZ5263BT1	1SMA5943BT3	1SMB5943BT3
60		MMBZ5264BLT1			MMSZ5264BT1		
62	BZX84C62LT1	MMBZ5265BLT1	MMSZ62T1		MMSZ5265BT1	1SMA5944BT3	1SMB5944BT3
68	BZX84C68LT1	MMBZ5266BLT1	MMSZ68T1		MMSZ5266BT1	1SMA5945BT3	1SMB5945BT3
75	BZX84C75LT1	MMBZ5267BLT1	MMSZ75T1		MMSZ5267BT1		1SMB5946BT3
82		MMBZ5268BLT1			MMSZ5268BT1		1SMB5947BT3
87		MMBZ5269BLT1			MMSZ5269BT1		
91		MMBZ5270BLT1			MMSZ5270BT1		
100					MMSZ5271BT1		1SMB5949BT3
110							1SMB5950BT3
120							1SMB5951BT3
130							1SMB5952BT3
150							1SMB5953BT3
160							1SMB5954BT3
170							
180							
200							

\*See Notes page 5.2-26.

Devices listed in bold, italic are Motorola preferred devices.

# Zener Diodes

## Notes — Surface Mount Chart

1. *Zener Voltage* is the key parameter for each device type. It is specified at a particular test current applied at either thermal equilibrium (T.E.) or pulse test condition. The voltage tolerance for the device types listed is, in general  $\pm 5\%$ ; however, for some series, the voltage tolerance varies from device type to device type over a range of  $\pm(5$  to  $8.5)\%$ . Consult the complete data sheet to determine the exact test conditions and minimum/maximum limits for the zener voltage.

*Power Ratings* represent the capability of the case size listed as supplied by Motorola. These ratings may be higher than the same device types supplied by other manufacturers.

### **$V_Z$ Test Conditions and Tolerances**

2. *BZX84C2V4L–C24LT1*  $I_{ZT} = 5$  mA (pulse).  
*BZX84C27L–C75LT1*  
 $I_{ZT} = 2$  mA (pulse).

Tolerance is  $\pm(5$  to  $8.5)\%$  depending on type number. Each device type also has other  $V_Z$  min/max limits at two other  $I_{ZT}$  pulse current values.

3. *MMBZ5221BL–42BLT1*  $I_{ZT} = 20$  mA (pulse).  
*MMBZ5243BL–70BLT1*  
 $I_{ZT}$  @ approximately 125 mW point (pulse).  
BL suffix =  $\pm 5\%$ .

4. *MMSZ2V4–24T1*  $I_{ZT} = 5$  mA (pulse).  
*MMSZ27–56T1*  $I_{ZT} = 2$  mA (pulse).

Tolerance is  $\pm(5$  to  $8.5)\%$  depending on type number. Each device type also has other  $V_Z$  min/max limits at two other  $I_{ZT}$  pulse current values.

5. *MMSZ4678T1 Series*  $I_{ZT} = 50$   $\mu$ A (T.E.).  
No suffix =  $\pm 5\%$ .

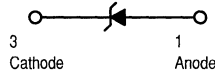
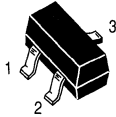
6. *MMSZ5221B–42BT1*  $I_{ZT} = 20$  mA (T.E.).  
*MMSZ5243B–63BT1*  
 $I_{ZT}$  @ approximately 125 mW point (T.E.).  
A suffix =  $\pm 10\%$ .  
B suffix =  $\pm 5\%$ .

7. *1SMA5913BT3 Series*  
 $I_{ZT}$  @ approximately 375 mW point (T.E.).  
BT3 suffix =  $\pm 5\%$ .  
T3 suffix designates tape and reel of 2500 units.

8. *1SMB5913BT3 Series*  
 $I_{ZT}$  @ approximately 750 mW point (T.E.).  
BT3 suffix =  $\pm 5\%$ .  
T3 suffix designates tape and reel of 2500 units.

# Zener Diodes

Table 17. 225 mW Rating on FR-5 Board – Case 318-08 – SOT-23



CASE 318-08, STYLE 8  
SOT-23 (TO-236AB)  
PLASTIC

**ELECTRICAL CHARACTERISTICS (Pinout: 1–Anode, 2–NC, 3–Cathode) ( $V_F = 0.9\text{ V Max @ } I_F = 10\text{ mA}$  for all types)**

Type Number	Marking	Zener Voltage $V_{Z1}$ (Volts) @ $I_{ZT1} = 5\text{ mA}$ (1)			Max Zener Impedance $Z_{ZT1}$ (Ohms) @ $I_{ZT1} = 5\text{ mA}$	Max Reverse Leakage Current @ $V_R$ mA Volts		Zener Voltage $V_{Z2}$ (Volts) @ $I_{ZT2} = 1\text{ mA}$ (1)		Max Zener Impedance $Z_{ZT2}$ (Ohms) @ $I_{ZT2} = 1\text{ mA}$	Zener Voltage $V_{Z3}$ (Volts) @ $I_{ZT3} = 20\text{ mA}$ (1)		Max Zener Impedance $Z_{ZT3}$ (Ohms) @ $I_{ZT3} = 20\text{ mA}$		$dV_Z/dt$ (mV/k) @ $I_{ZT1} = 5\text{ mA}$		C <sub>pF</sub> Max @ $V_R = 0$ f = 1 MHz
		Nom	Min	Max		$I_R$	$V_R$	Min	Max		Min	Max	Min	Max	Min	Max	
BZX84C2V4LT1	Z11	2.4	2.2	2.6	100	50	1	1.7	2.1	600	2.6	3.2	50	-3.5	0	450	
BZX84C2V7LT1	Z12	2.7	2.5	2.9	100	20	1	1.9	2.4	600	3	3.6	50	-3.5	0	450	
BZX84C3V0LT1	Z13	3	2.8	3.2	95	10	1	2.1	2.7	600	3.3	3.9	50	-3.5	0	450	
BZX84C3V3LT1	Z14	3.3	3.1	3.5	95	5	1	2.3	2.9	600	3.6	4.2	40	-3.5	0	450	
BZX84C3V6LT1	Z15	3.6	3.4	3.8	90	5	1	2.7	3.3	600	3.9	4.5	40	-3.5	0	450	
BZX84C3V9LT1	Z16	3.9	3.7	4.1	90	3	1	2.9	3.5	600	4.1	4.7	30	-3.5	-2.5	450	
BZX84C4V3LT1	W9	4.3	4	4.6	90	3	1	3.3	4	600	4.4	5.1	30	-3.5	0	450	
<b>BZX84C4V7LT1</b>	Z1	4.7	4.4	5	80	3	2	3.7	4.7	500	4.5	5.4	15	-3.5	0.2	260	
<b>BZX84C5V1LT1</b>	Z2	5.1	4.8	5.4	60	2	2	4.2	5.3	480	5	5.9	15	-2.7	1.2	225	
<b>BZX84C5V6LT1</b>	Z3	5.6	5.2	6	40	1	2	4.8	6	400	5.2	6.3	10	-2.0	2.5	200	
<b>BZX84C6V2LT1</b>	Z4	6.2	5.8	6.6	10	3	4	5.6	6.6	150	5.8	6.8	6	0.4	3.7	185	
BZX84C6V8LT1	Z5	6.8	6.4	7.2	15	2	4	6.3	7.2	80	6.4	7.4	6	1.2	4.5	155	
BZX84C7V5LT1	Z6	7.5	7	7.9	15	1	5	6.9	7.9	80	7	8	6	2.5	5.3	140	
BZX84C8V2LT1	Z7	8.2	7.7	8.7	15	0.7	5	7.6	8.7	80	7.7	8.8	6	3.2	6.2	135	
BZX84C9V1LT1	Z8	9.1	8.5	9.6	15	0.5	6	8.4	9.6	100	8.5	9.7	8	3.8	7.0	130	
BZX84C10LT1	Z9	10	9.4	10.6	20	0.2	7	9.3	10.6	150	9.4	10.7	10	4.5	8.0	130	
BZX84C11LT1	Y1	11	10.4	11.6	20	0.1	8	10.2	11.6	150	10.4	11.8	10	5.4	9.0	130	
<b>BZX84C12LT1</b>	Y2	12	11.4	12.7	25	0.1	8	11.2	12.7	150	11.4	12.9	10	6.0	10.0	130	
BZX84C13LT1	Y3	13	12.4	14.1	30	0.1	8	12.3	14	170	12.5	14.2	15	7.0	11.0	120	
BZX84C15LT1	Y4	15	13.8	15.6	30	0.05	10.5	13.7	15.5	200	13.9	15.7	20	9.2	13.0	110	
BZX84C16LT1	Y5	16	15.3	17.1	40	0.05	11.2	15.2	17	200	15.4	17.2	20	10.4	14.0	105	
<b>BZX84C18LT1</b>	Y6	18	16.8	19.1	45	0.05	12.6	16.7	19	225	16.9	19.2	20	12.4	16.0	100	
BZX84C20LT1	Y7	20	18.8	21.2	55	0.05	14	18.7	21.1	225	18.9	21.4	20	14.4	18.0	85	
BZX84C22LT1	Y8	22	20.8	23.3	55	0.05	15.4	20.7	23.2	250	20.9	23.4	25	16.4	20.0	85	
BZX84C24LT1	Y9	24	22.8	25.6	70	0.05	16.8	22.7	25.5	250	22.9	25.7	25	18.4	22.0	80	
					$Z_{ZT1}$ Below @ $I_{ZT1} = 2\text{ mA}$					$Z_{ZT2}$ Below @ $I_{ZT2} = 0.1\text{ mA}$			$Z_{ZT3}$ Below @ $I_{ZT3} = 10\text{ mA}$			$dV_Z/dt$ (mV/k) Below @ $I_{ZT1} = 2\text{ mA}$	
BZX84C27LT1	Y10	27	25.1	28.9	80	0.05	18.9	25	28.9	300	25.2	29.3	45	21.4	25.3	70	
BZX84C30LT1	Y11	30	28	32	80	0.05	21	27.8	32	300	28.1	32.4	50	24.4	29.4	70	
BZX84C33LT1	Y12	33	31	35	80	0.05	23.1	30.8	35	325	31.1	35.4	55	27.4	33.4	70	
BZX84C36LT1	Y13	36	34	38	90	0.05	25.2	33.8	38	350	34.1	38.4	60	30.4	37.4	70	
BZX84C39LT1	Y14	39	37	41	130	0.05	27.3	36.7	41	350	37.1	41.5	70	33.4	41.2	45	
BZX84C43LT1	Y15	43	40	46	150	0.05	30.1	39.7	46	375	40.1	46.5	80	37.6	46.6	40	
BZX84C47LT1	Y16	47	44	50	170	0.05	32.9	43.7	50	375	44.1	50.5	90	42.0	51.8	40	
BZX84C51LT1	Y17	51	48	54	180	0.05	35.7	47.6	54	400	48.1	54.6	100	46.6	57.2	40	
BZX84C56LT1	Y18	56	52	60	200	0.05	39.2	51.5	60	425	52.1	60.8	110	52.2	63.8	40	
BZX84C62LT1	Y19	62	58	66	215	0.05	43.4	57.4	66	450	58.2	67	120	58.8	71.6	35	
BZX84C68LT1	Y20	68	64	72	240	0.05	47.6	63.4	72	475	64.2	73.2	130	65.6	79.8	35	
BZX84C75LT1	Y21	75	70	79	255	0.05	52.5	69.4	79	500	70.3	80.2	140	73.4	88.6	35	

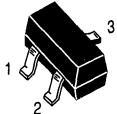
(1)  $V_Z$  is measured with a pulse test current ( $I_{ZT}$ ) applied at an ambient temperature of 25°C.

(2) The zener impedance,  $Z_{ZT2}$ , for the 27 through 75 volt types is tested at 0.5 mA rather than the test current of 0.1 mA used for  $V_{Z2}$ .

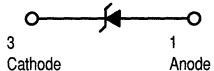
Devices listed in bold, italic are Motorola preferred devices.

# Zener Diodes

Table 18. 225 mW Rating on FR-5 Board – Case 318-08 – SOT-23



**CASE 318-08, STYLE 8**  
**SOT-23 (TO-236AB)**  
**PLASTIC**



ELECTRICAL CHARACTERISTICS (Pinout: 1–Anode, 2–NC, 3–Cathode) ( $V_F = 0.9\text{ V Max @ } I_F = 10\text{ mA}$ for all types.)							
Device	Marking	Test Current $I_{ZT}$ mA	Zener Voltage $V_Z (\pm 5\%)$ Nominal <sup>(1)</sup>	Z <sub>ZK</sub> $I_Z = 0.25\text{ mA}$ $\Omega$ Max	Z <sub>ZT</sub> $I_Z = I_{ZT}$ @ 10% Mode $\Omega$ Max	Max $I_R$ @ $\mu\text{A}$	$V_R$  V
MMBZ5221BLT1	18A	20	2.4	1200	30	100	1
MMBZ5222BLT1	18B	20	2.5	1250	30	100	1
MMBZ5225BLT1	18E	20	3	1600	29	50	1
MMBZ5226BLT1	8A	20	3.3	1600	28	25	1
<b>MMBZ5228BLT1</b>	8C	20	3.9	1900	23	10	1
MMBZ5229BLT1	8D	20	4.3	2000	22	5	1
MMBZ5230BLT1	8E	20	4.7	1900	19	5	2
<b>MMBZ5231BLT1</b>	8F	20	5.1	1600	17	5	2
<b>MMBZ5232BLT1</b>	8G	20	5.6	1600	11	5	3
MMBZ5233BLT1	8H	20	6	1600	7	5	3.5
<b>MMBZ5234BLT1</b>	8J	20	6.2	1000	7	5	4
<b>MMBZ5235BLT1</b>	8K	20	6.8	750	5	3	5
MMBZ5236BLT1	8L	20	7.5	500	6	3	6
MMBZ5237BLT1	8M	20	8.2	500	8	3	6.5
MMBZ5239BLT1	8P	20	9.1	600	10	3	7
<b>MMBZ5240BLT1</b>	8Q	20	10	600	17	3	8
MMBZ5241BLT1	8R	20	11	600	22	2	8.4
<b>MMBZ5242BLT1</b>	8S	20	12	600	30	1	9.1
MMBZ5243BLT1	8T	9.5	13	600	13	0.5	9.9
MMBZ5244BLT1	8U	9	14	600	15	0.1	10
<b>MMBZ5245BLT1</b>	8V	8.5	15	600	16	0.1	11
MMBZ5246BLT1	8W	7.8	16	600	17	0.1	12
MMBZ5247BLT1	8X	7.4	17	600	19	0.1	13
<b>MMBZ5248BLT1</b>	8Y	7	18	600	21	0.1	14
MMBZ5249BLT1	8Z	6.6	19	600	23	0.1	14
<b>MMBZ5250BLT1</b>	81A	6.2	20	600	25	0.1	15
MMBZ5251BLT1	81B	5.6	22	600	29	0.1	17
MMBZ5252BLT1	81C	5.2	24	600	33	0.1	18
<b>MMBZ5254BLT1</b>	81E	4.6	27	600	41	0.1	21
MMBZ5255BLT1	81F	4.5	28	600	44	0.1	21
MMBZ5256BLT1	81G	4.2	30	600	49	0.1	23
<b>MMBZ5257BLT1</b>	81H	3.8	33	700	58	0.1	25
MMBZ5258BLT1	81J	3.4	36	700	70	0.1	27
MMBZ5259BLT1	81K	3.2	39	800	80	0.1	30

(1)  $V_Z$  is measured at pulse test current ( $I_{ZT}$ ) at an ambient temperature of 25°C.

Devices listed in bold, italic are Motorola preferred devices.



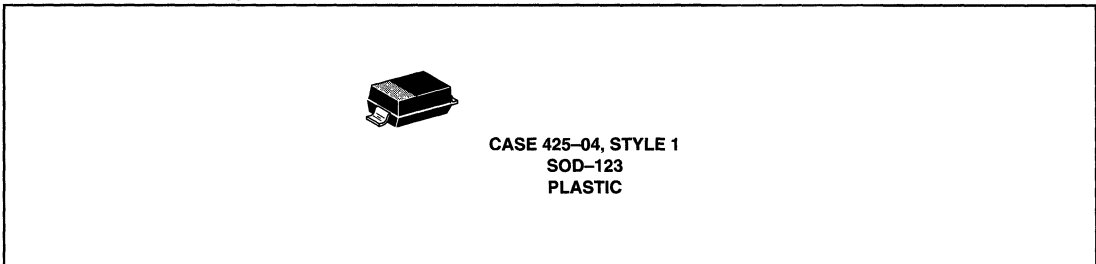
# Zener Diodes

Table 18. 225 mW Rating on FR-5 Board – Case 318-08 – SOT-23 (continued)

ELECTRICAL CHARACTERISTICS (Pinout: 1–Anode, 2–NC, 3–Cathode) ( $V_F = 0.9\text{ V Max @ } I_F = 10\text{ mA}$ for all types.)								
Device	Marking	Test Current $I_{ZT}$ mA	Zener Voltage $V_Z (\pm 5\%)$ Nominal <sup>(1)</sup>	$Z_{ZK}$ $I_Z = 0.25\text{ mA}$ $\Omega$ Max	$Z_{ZT}$ $I_Z = I_{ZT}$ @ 10% Mode $\Omega$ Max	Max		
						$I_R$ @ $\mu\text{A}$	$V_R$	V
MMBZ5261BLT1	81M	2.7	47	1000	105	0.1		36
MMBZ5262BLT1	81N	2.5	51	1100	125	0.1		39
MMBZ5263BLT1	81P	2.2	56	1300	150	0.1		43
MMBZ5265BLT1	81R	2	62	1400	185	0.1		47
MMBZ5266BLT1	81S	1.8	68	1600	230	0.1		52
MMBZ5268BLT1	81U	1.5	82	2000	330	0.1		62
MMBZ5269BLT1	81V	1.4	87	2200	370	0.1		68
MMBZ5270BLT1	81W	1.4	91	2300	400	0.1		69

(1)  $V_Z$  is measured at pulse test current ( $I_{ZT}$ ) at an ambient temperature of 25°C.

Table 19. 500 mW Rating on FR-4 or FR-5 Board – Case 425-04 – SOD-123



ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$  unless otherwise noted<sup>(1)</sup>, ( $V_F = 0.9\text{ V Max. @ } I_F = 10\text{ mA}$  for all types)

Type Number	Marking	Zener Voltage $V_Z @ I_{ZT}$ Volts(1, 2, 3)			Test Voltage $V_R$ Volts	Max Zener Impedance <sup>(4)</sup>		Max Reverse Leakage Current $I_R @ V_R$ $\mu\text{A}$	Test Voltage $V_R$ Volts
		Nom	Min	Max		$Z_{ZT}$ @ $I_Z = I_{ZT}$ $\Omega$	$Z_{ZK}$ @ $I_{ZK} = 0.25\text{ mA}$ $\Omega$		
<b>MMSZ5221BT1</b>	C1	2.4	2.28	2.52	20	30	1200	100	1
<b>MMSZ5222BT1</b>	C2	2.5	2.38	2.63	20	30	1250	100	1
MMSZ5223BT1	C3	2.7	2.57	2.84	20	30	1300	75	1
MMSZ5224BT1	C4	2.8	2.66	2.94	20	30	1400	75	1
<b>MMSZ5225BT1</b>	C5	3.0	2.85	3.15	20	30	1600	50	1
MMSZ5226BT1	D1	3.3	3.14	3.47	20	28	1600	25	1
MMSZ5227BT1	D2	3.6	3.42	3.78	20	24	1700	15	1
MMSZ5228BT1	D3	3.9	3.71	4.10	20	23	1900	10	1
<b>MMSZ5229BT1</b>	D4	4.3	4.09	4.52	20	22	2000	5	1
<b>MMSZ5230BT1</b>	D5	4.7	4.47	4.94	20	19	1900	5	2

(1) Nominal zener voltage is measured with the device junction in thermal equilibrium at  $T_L = 30^\circ\text{C} \pm 1^\circ\text{C}$ .

(2) All part numbers shown indicate a  $V_Z$  tolerance of  $\pm 5\%$ .

(3)  $V_Z$  is measured at pulse test current ( $I_{ZT}$ ) at an ambient temperature of 25°C.

(4)  $Z_{ZT}$  and  $Z_{ZK}$  are measured by dividing the AC voltage drop across the device by the AC current applied.

The specified limits are for  $I_{Z(AC)} = 0.1 I_{Z(DC)}$ , with the AC frequency = 1 kHz.

Devices listed in bold, italic are Motorola preferred devices.

# Zener Diodes

Table 19. 500 mW Rating on FR-4 or FR-5 Board – Case 425-04 – SOD-123 (continued)

ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ unless otherwise noted <sup>(1)</sup> , ( $V_F = 0.9\text{ V Max.}$ @ $I_F = 10\text{ mA}$ for all types)									
Type Number	Marking	Zener Voltage $V_Z$ @ $I_{ZT}$ Volts(1,2, 3)			Test Voltage $V_R$ Volts	Max Zener Impedance(4)		Max Reverse Leakage Current $I_R$ @ $V_R$ $\mu\text{A}$	Test Voltage $V_R$ Volts
		Nom	Min	Max		$Z_{ZT}$ @ $I_Z = I_{ZT}$ $\Omega$	$Z_{ZK}$ @ $I_{ZK} = 0.25\text{ mA}$ $\Omega$		
<b>MMSZ5231BT1</b>	E1	5.1	4.85	5.36	20	17	1600	5	2
<b>MMSZ5232BT1</b>	E2	5.6	5.32	5.88	20	11	1600	5	3
MMSZ5233BT1	E3	6.0	5.70	6.30	20	7	1600	5	3.5
<b>MMSZ5234BT1</b>	E4	6.2	5.89	6.51	20	7	1000	5	4
<b>MMSZ5235BT1</b>	E5	6.8	6.46	7.14	20	5	750	3	5
MMSZ5236BT1	F1	7.5	7.13	7.88	20	6	500	3	6
MMSZ5237BT1	F2	8.2	7.79	8.61	20	8	500	3	6.5
MMSZ5238BT1	F3	8.7	8.27	9.14	20	8	600	3	6.5
MMSZ5239BT1	F4	9.1	8.65	9.56	20	10	600	3	7
<b>MMSZ5240BT1</b>	F5	10	9.50	10.50	20	17	600	3	8
MMSZ5241BT1	H1	11	10.45	11.55	20	22	600	2	8.4
<b>MMSZ5242BT1</b>	H2	12	11.40	12.60	20	30	600	1	9.1
MMSZ5243BT1	H3	13	12.35	13.65	9.5	13	600	0.5	9.9
MMSZ5244BT1	H4	14	13.30	14.70	9.0	15	600	0.1	10
<b>MMSZ5245BT1</b>	H5	15	14.25	15.75	8.5	16	600	0.1	11
<b>MMSZ5246BT1</b>	J1	16	15.20	16.80	7.8	17	600	0.1	12
MMSZ5247BT1	J2	17	16.15	17.85	7.4	19	600	0.1	13
<b>MMSZ5248BT1</b>	J3	18	17.10	18.90	7.0	21	600	0.1	14
MMSZ5249BT1	J4	19	18.05	19.95	6.6	23	600	0.1	14
<b>MMSZ5250BT1</b>	J5	20	19.00	21.00	6.2	25	600	0.1	15
MMSZ5251BT1	K1	22	20.90	23.10	5.6	29	600	0.1	17
<b>MMSZ5252BT1</b>	K2	24	22.80	25.20	5.2	33	600	0.1	18
MMSZ5253BT1	K3	25	23.75	26.25	5.0	35	600	0.1	19
<b>MMSZ5254BT1</b>	K4	27	25.65	28.35	4.6	41	600	0.1	21
MMSZ5255BT1	K5	28	26.60	29.40	4.5	44	600	0.1	21
<b>MMSZ5256BT1</b>	M1	30	28.50	31.50	4.2	49	600	0.1	23
MMSZ5257BT1	M2	33	31.35	34.65	3.8	58	700	0.1	25
MMSZ5258BT1	M3	36	34.20	37.80	3.4	70	700	0.1	27
MMSZ5259BT1	M4	39	37.05	40.95	3.2	80	800	0.1	30
MMSZ5260BT1	M5	43	40.85	45.15	3.0	93	900	0.1	33
<b>MMSZ5261BT1</b>	N1	47	44.65	49.35	2.7	105	1000	0.1	36
MMSZ5262BT1	N2	51	48.45	53.55	2.5	125	1100	0.1	39
MMSZ5263BT1	N3	56	53.20	58.80	2.2	150	1300	0.1	43
MMSZ5264BT1	N4	60	57.00	63.00	2.1	170	1400	0.1	46
MMSZ5265BT1	N5	62	58.90	65.10	2.0	185	1400	0.1	47
MMSZ5266BT1	P1	68	64.60	71.40	1.8	230	1600	0.1	52
MMSZ5267BT1	P2	75	71.25	78.75	1.7	270	1700	0.1	56
MMSZ5268BT1	P3	82	77.90	86.10	1.5	330	2000	0.1	62
MMSZ5269BT1	P4	87	82.65	91.35	1.4	370	2200	0.1	68
MMSZ5270BT1	P5	91	86.45	95.55	1.4	400	2300	0.1	69

(1) Nominal zener voltage is measured with the device junction in thermal equilibrium at  $T_L = 30^\circ\text{C} \pm 1^\circ\text{C}$ .

(2) All part numbers shown indicate a  $V_Z$  tolerance of  $\pm 5\%$ .

(3)  $V_Z$  is measured at pulse test current ( $I_{ZT}$ ) at an ambient temperature of  $25^\circ\text{C}$ .

(4)  $Z_{ZT}$  and  $Z_{ZK}$  are measured by dividing the AC voltage drop across the device by the AC current applied.

The specified limits are for  $I_{Z(AC)} = 0.1 I_{Z(DC)}$ , with the AC frequency = 1 kHz.

Devices listed in bold, italic are Motorola preferred devices.

# Zener Diodes

**Table 20. 500 mW Rating on FR-4 or FR-5 Board – Case 425-04 – SOD-123**

ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ unless otherwise noted <sup>(1)</sup> , ( $V_F = 0.9\text{ V Max. @ } I_F = 10\text{ mA}$ for all types)						
Type Number	Marking	Zener Voltage $V_Z @ I_{ZT} = 50\ \mu\text{A}$ Volts <sup>(1, 2)</sup>			Max Reverse Leakage Current $I_R @ V_R$ $\mu\text{A}$	Test Voltage $V_R$ Volts
		Nom	Min	Max		
MMSZ4678T1	CC	1.8	1.71	1.89	7.5	1
MMSZ4679T1	CD	2.0	1.90	2.10	5	1
<b>MMSZ4680T1</b>	CE	2.2	2.09	2.31	4	1
MMSZ4681T1	CF	2.4	2.28	2.52	2	1
MMSZ4682T1	CH	2.7	2.57	2.84	1	1
MMSZ4683T1	CJ	3.0	2.85	3.15	0.8	1
MMSZ4684T1	CK	3.3	3.14	3.47	7.5	1.5
<b>MMSZ4685T1</b>	CM	3.6	3.42	3.78	7.5	2
MMSZ4686T1	CN	3.9	3.71	4.10	5	2
MMSZ4687T1	CP	4.3	4.09	4.52	4	2
<b>MMSZ4688T1</b>	CT	4.7	4.47	4.94	10	3
<b>MMSZ4689T1</b>	CU	5.1	4.85	5.36	10	3
<b>MMSZ4690T1</b>	CV	5.6	5.32	5.88	10	4
MMSZ4691T1	CA	6.2	5.89	6.51	10	5
MMSZ4692T1	CX	6.8	6.46	7.14	10	5.1
MMSZ4693T1	CY	7.5	7.13	7.88	10	5.7
MMSZ4694T1	CZ	8.2	7.79	8.61	1	6.2
MMSZ4695T1	DC	8.7	8.27	9.14	1	6.6
MMSZ4696T1	DD	9.1	8.65	9.56	1	6.9
MMSZ4697T1	DE	10	9.50	10.50	1	7.6
MMSZ4698T1	DF	11	10.45	11.55	0.05	8.4
MMSZ4699T1	DH	12	11.40	12.60	0.05	9.1
MMSZ4700T1	DJ	13	12.35	13.65	0.05	9.8
MMSZ4701T1	DK	14	13.30	14.70	0.05	10.6
MMSZ4702T1	DM	15	14.25	15.75	0.05	11.4
MMSZ4703T1	DN	16	15.20	16.80	0.05	12.1
MMSZ4704T1	DP	17	16.15	17.85	0.05	12.9
MMSZ4705T1	DT	18	17.10	18.90	0.05	13.6
MMSZ4706T1	DU	19	18.05	19.95	0.05	14.4
MMSZ4707T1	DV	20	19.00	21.00	0.01	15.2
MMSZ4708T1	DA	22	20.90	23.10	0.01	16.7
MMSZ4709T1	DZ	24	22.80	25.20	0.01	18.2
MMSZ4710T1	DY	25	23.75	26.25	0.01	19.00
MMSZ4711T1	EA	27	25.65	28.35	0.01	20.4
MMSZ4712T1	EC	28	26.60	29.40	0.01	21.2
MMSZ4713T1	ED	30	28.50	31.50	0.01	22.8
MMSZ4714T1	EE	33	31.35	34.65	0.01	25.0
MMSZ4715T1	EF	36	34.20	37.80	0.01	27.3
MMSZ4716T1	EH	39	37.05	40.95	0.01	29.6
MMSZ4717T1	EJ	43	40.85	45.15	0.01	32.6

<sup>(1)</sup> Nominal zener voltage is measured with the device junction in thermal equilibrium at  $T_L = 30^\circ\text{C} \pm 1^\circ\text{C}$ .

<sup>(2)</sup> All part numbers shown indicate a  $V_Z$  tolerance of  $\pm 5\%$ .

Devices listed in bold, italic are Motorola preferred devices.

# Zener Diodes

Table 21. 500 mW Rating on FR-4 or FR-5 Board — Case 425-04 — SOD-123

ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ unless otherwise noted <sup>(1)</sup> , ( $V_F = 0.9\text{ V Max.}$ @ $I_F = 10\text{ mA}$ for all types)										
Type Number	Marking	Zener Voltage $V_{Z1}$ (Volts) @ $I_{ZT1} = 5\text{ mA}$ (2, 3)			Max Zener Impedance $Z_{ZT1}$ @ $I_{ZT1} = 5\text{ mA}$ (21) $\Omega$	Max Reverse Leakage Current		Zener Voltage $V_{Z2}$ (Volts) @ $I_{ZT2} = 1\text{ mA}$ (3)		Max Zener Impedance $Z_{ZT2}$ @ $I_{ZT1} = 1\text{ mA}$ (4) $\Omega$
		Nom	Min	Max		$I_R$ $\mu\text{A}$	@ $V_R$ Volts	Min	Max	
MMSZ2V4T1	T1	2.4	2.28	2.52	100	50	1	1.7	2.1	600
MMSZ2V7T1	T2	2.7	2.57	2.84	100	20	1	1.9	2.4	600
MMSZ3V0T1	T3	3.0	2.85	3.15	95	10	1	2.1	2.7	600
MMSZ3V3T1	T4	3.3	3.14	3.47	95	5	1	2.3	2.9	600
MMSZ3V6T1	T5	3.6	3.42	3.78	90	5	1	2.7	3.3	600
MMSZ3V9T1	U1	3.9	3.71	4.10	90	3	1	2.9	3.5	600
MMSZ4V3T1	U2	4.3	4.09	4.52	90	3	1	3.3	4.0	600
MMSZ4V7T1	U3	4.7	4.47	4.94	80	3	2	3.7	4.7	500
<b>MMSZ5V1T1</b>	U4	5.1	4.85	5.36	60	2	2	4.2	5.3	480
<b>MMSZ5V6T1</b>	U5	5.6	5.32	5.88	40	1	2	4.8	6.0	400
<b>MMSZ6V2T1</b>	V1	6.2	5.89	6.51	10	3	4	5.6	6.6	150
MMSZ6V8T1	V2	6.8	6.46	7.14	15	2	4	6.3	7.2	80
MMSZ7V5T1	V3	7.5	7.13	7.88	15	1	5	6.9	7.9	80
MMSZ8V2T1	V4	8.2	7.79	8.61	15	0.7	5	7.6	8.7	80
MMSZ9V1T1	V5	9.1	8.65	9.56	15	0.5	6	8.4	9.6	100
MMSZ10T1	A1	10	9.50	10.50	20	0.2	7	9.3	10.6	150
MMSZ11T1	A2	11	10.45	11.55	20	0.1	8	10.2	11.6	150
MMSZ12T1	A3	12	11.40	12.60	25	0.1	8	11.2	12.7	150
MMSZ13T1	A4	13	12.35	13.65	30	0.1	8	12.3	14.0	170
MMSZ15T1	A5	15	14.25	15.75	30	0.05	10.5	13.7	15.5	200
MMSZ16T1	X1	16	15.20	16.80	40	0.05	11.2	15.2	17.0	200
<b>MMSZ18T1</b>	X2	18	17.10	18.90	45	0.05	12.6	16.7	19.0	225
MMSZ20T1	X3	20	19.00	21.00	55	0.05	14	18.7	21.1	225
MMSZ22T1	X4	22	20.80	23.10	55	0.05	15.4	20.7	23.2	250
MMSZ24T1	X5	24	22.80	25.20	70	0.05	16.8	22.7	25.5	250

(1) Nominal zener voltage is measured with the device junction in thermal equilibrium at  $T_L = 30^\circ\text{C} \pm 1^\circ\text{C}$ .

(2) All part numbers shown indicate a  $V_Z$  tolerance of  $\pm 5\%$ .

(3) Zener voltage is measured with the zener current applied for  $PW = 1.0\text{ ms}$ .

(4)  $Z_{ZT}$  and  $Z_{ZK}$  are measured by dividing the AC voltage drop across the device by the AC current applied. The specified limits are for  $I_{Z(AC)} = 0.1 I_{Z(DC)}$ , with the AC frequency = 1 kHz.

Devices listed in bold, italic are Motorola preferred devices.

# Zener Diodes

**Table 21. 500 mW Rating on FR-4 or FR-5 Board — Case 425-04 — SOD-123 (continued)**

ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ unless otherwise noted <sup>(1)</sup> , ( $V_F = 0.9\text{ V Max. @ } I_F = 10\text{ mA}$ for all types)										
Type Number	Marking	Zener Voltage $V_{Z1}$ (Volts) @ $I_{ZT1} = 2\text{ mA}$ (2, 3)			Max Zener Impedance $Z_{ZT1}$ @ $I_{ZT1} = 2\text{ mA}$ (4) $\Omega$	Max Reverse Leakage Current		Zener Voltage $V_{Z2}$ (Volts) @ $I_{ZT2} = 0.1\text{ mA}$ (3)		Max Zener Impedance $Z_{ZT2}$ @ $I_{ZT1} = 0.5\text{ mA}$ (4, 5) $\Omega$
		Nom	Min	Max		$I_R$ $\mu\text{A}$	@ $V_R$ Volts	Min	Max	
MMSZ27T1	Y1	27	25.65	28.35	80	0.05	18.9	25	28.9	300
MMSZ30T1	Y2	30	28.50	31.50	80	0.05	21	27.8	32	300
MMSZ33T1	Y3	33	31.35	34.65	80	0.05	23.1	30.8	35	325
MMSZ36T1	Y4	36	34.20	37.80	90	0.05	25.2	33.8	38	350
<b>MMSZ39T1</b>	Y5	39	37.05	40.95	130	0.05	27.3	36.7	41	350
MMSZ43T1	Z1	43	40.85	45.15	150	0.05	30.1	39.7	46	375
MMSZ47T1	Z2	47	44.65	49.35	170	0.05	32.9	43.7	50	375
MMSZ51T1	Z3	51	48.45	53.55	180	0.05	35.7	47.6	54	400
MMSZ56T1	Z4	56	53.20	58.80	200	0.05	39.2	51.5	60	425
MMSZ62T1	Z5	62	58.90	65.10	215	0.05	43.4	57.4	66	450
MMSZ68T1	Z6	68	64.60	71.40	240	0.05	47.6	63.4	72	475
MMSZ75T1	Z7	75	71.25	78.75	255	0.05	52.5	69.4	79	500

(1) Nominal zener voltage is measured with the device junction in thermal equilibrium at  $T_L = 30^\circ\text{C} \pm 1^\circ\text{C}$ .

(2) All part numbers shown indicate a  $V_Z$  tolerance of  $\pm 5\%$

(3) Zener voltage is measured with the zener current applied for  $PW = 1.0\text{ ms}$ .

(4)  $Z_{ZT}$  and  $Z_{ZK}$  are measured by dividing the AC voltage drop across the device by the AC current applied. The specified (limits are for  $I_{Z(AC)} = 0.1 I_{Z(DC)}$ , with the AC frequency = 1 kHz

(5) The zener impedance,  $Z_{ZT2}$ , for the 27 through 75 volt types is tested at 0.5 mA rather than the test current of 0.1 mA used for  $V_{Z2}$ .

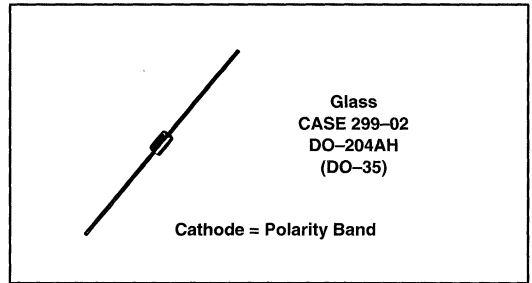
Devices listed in bold, italic are Motorola preferred devices.

# Voltage Reference Diodes

## Temperature Compensated Reference Devices

For applications where output voltage must remain within narrow limits during changes in input voltage, load resistance and temperature. Motorola guarantees all reference devices to fall within the specified maximum voltage variations,  $\Delta V_Z$ , at the specifically indicated test temperatures and test current (JEDEC Standard #5). Temperature coefficient is also specified but should be considered as a reference only — not a maximum rating.

Devices in this table are hermetically sealed structures.



**Table 22. Temperature Compensated Reference Devices**

V <sub>Z</sub> Volts	Test Current mA	Test(2) Temp Points	AVERAGE TEMPERATURE COEFFICIENT OVER THE OPERATING RANGE									
			0.01 %/°C		0.005 %/°C		0.002 %/°C		0.001 %/°C		0.0005 %/°C	
			Device Type	$\Delta V_Z$ Max Volts	Device Type	$\Delta V_Z$ Max Volts	Device Type	$\Delta V_Z$ Max Volts	Device Type	$\Delta V_Z$ Max Volts	Device Type	$\Delta V_Z$ Max Volts
6.2(1)	7.5	A	<b>1N821</b>	0.096	<b>1N823</b>	0.048	<b>1N825</b>	0.019	1N827	0.009	1N829	0.005
6.2(1)	7.5	A	<b>1N821A</b>	0.096	<b>1N823A</b>	0.048	<b>1N825A</b>	0.019	1N827A	0.009	1N829A	0.005

(1) Non-suffix —  $Z_{ZT} = 15$  ohms, "A" Suffix —  $Z_{ZT} = 10$  ohms

(2) Test Temperature Points °C: A = -55, 0, +25, +75, +100

## Current Regulator Diodes

High impedance diodes whose "constant current source" characteristic complements the "constant voltage" of the zener line. Currents are available from 0.22 to 4.7 mA, with usable voltage range from a minimum limit of 1.0 to 2.5 Volts, up to a voltage compliance of 100 Volts, for the 1N5283 series.

**Table 23. Current Regulator Diodes**

 CASE 51-02 DO-204AA - GLASS (DO-7)							
ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ unless otherwise noted)							
Type No.	Regulator Current $I_p$ (mA) @ $V_T = 25$ V			Minimum Dynamic Impedance @ $V_T = 25$ V $Z_T$ (M $\Omega$ )	Minimum Knee Impedance @ $V_K = 6.0$ V $Z_K$ (M $\Omega$ )	Maximum Limiting Voltage @ $I_L = 0.8 I_p$ (min) $V_L$ (Volts)	
	Nom	Min	Max				
<b>1N5283</b>	0.22	0.198	0.242	25.0	2.75	1.00	
<b>1N5287</b>	0.33	0.297	0.363	6.6	1.35	1.00	
<b>1N5297</b>	1.00	0.900	1.100	0.800	0.205	1.35	
<b>1N5298</b>	1.00	0.900	1.210	0.700	0.180	1.40	
<b>1N5305</b>	2.00	1.80	2.20	0.395	0.061	1.85	
<b>1N5309</b>	3.00	2.70	3.30	0.300	0.029	2.25	
1N5310	3.30	2.97	3.63	0.280	0.024	2.35	
1N5311	3.60	3.24	3.96	0.265	0.020	2.50	
<b>1N5312</b>	3.90	3.51	4.29	0.255	0.017	2.60	
<b>1N5313</b>	4.30	3.87	4.73	0.245	0.014	2.75	
<b>1N5314</b>	4.70	4.23	5.17	0.235	0.012	2.90	

Devices listed in bold, italic are Motorola preferred devices.

# Hybrid Power Module Operation

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## In Brief . . .

The Motorola Semiconductor Products Sector is proud to announce the formation of a new group: Hybrid Power Modules. Our operation has been in existence since August of 1992, and we're chartering new ground to become the world's fastest supplier of intelligent, energy efficient power modules for motor drive and uninterruptable power supply applications.

It's an exciting market, with 50 million motors being manufactured per year, and fewer than 5% of those using electronically controlled drives. Motorola Hybrid Power Modules will play a major role in supplying those power modules.

With Motorola's technology breadth, we're well positioned to develop highly integrated, intelligent IGBT (insulated gate bipolar transistor) power modules. The IGBT technology combines high current handling capability with low input current requirements in a smaller form factor which enables the design of more compact inverters. We have the capabilities to support custom modules (based on annual volume requirements) and offer the fastest possible time to market. Present integrated IGBT modules range from 5 to 30 amps, 600 and 1200 volts are also in our product portfolio. Our plans for the future include a family of advanced modules for applications in higher current and higher voltage devices and control networks.

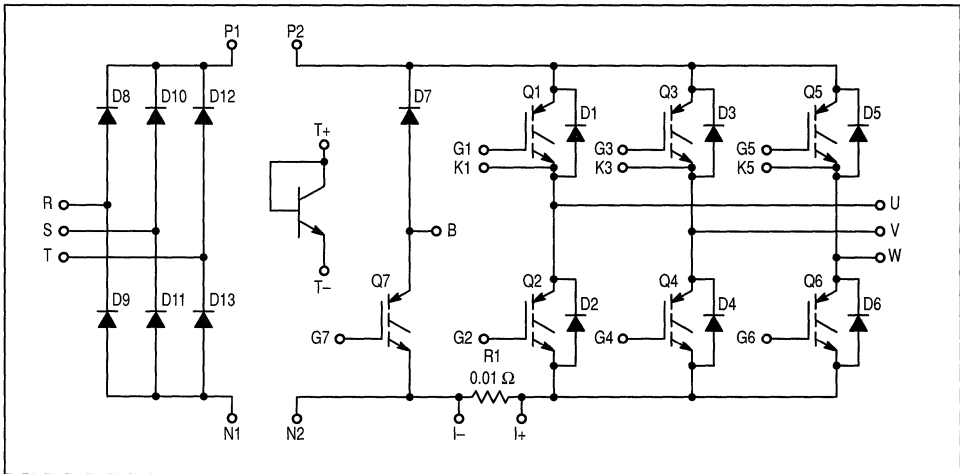
To summarize, we believe that we offer the leading edge technology combined with a state-of-the-art flexible manufacturing line and rapid cycle time that can give you the unique ability to differentiate your products in this highly competitive market.

	Page
Integrated Power Stage IGBT .....	5.3-2

**Table 1. Integrated Power Stage IGBT**

V <sub>CES</sub> (V)	Maximum Ratings				
	I <sub>C</sub> (A)				
	5	10	15	20–25	30
600			<b>MHPM7A15A60A</b> 6/94	<b>MHPM7A20A60A</b> 10/94	<b>MHPM7A30A60B</b> 5/95
1200	<b>MHPM7A8A120A</b> 7/94	<b>MHPM7A12A120A</b> 1/95	<b>MHPM7A16A120B</b> 5/95	<b>MHPM7A25A120B</b> 9/95	

**CIRCUIT**



Includes sense resistor and temperature sensor.

**Benefits of Motorola Integrated Power Stage**

- combines a 3-phase input rectifier bridge, output inverter and brake transistor in one package
- utilizes Motorola's advanced 600 & 1200 V IGBTs with matched soft free-wheeling diodes
- positive and negative bus access to designer
- temperature and current sense integrated in module

Devices listed in bold, italic are Motorola preferred devices.



# TMOS Power MOSFETs Products

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## In Brief . . .

Motorola continues to build a world class portfolio of TMOS Power MOSFETs with new advances in silicon and packaging technology. The following new advances have been made in the area of silicon technology.

- New high voltage devices with voltages up to 1200 volts.
- New High Cell Density (HDTMOS) family of standard and Logic Level devices in both N and P-channel are available in DPAK, D<sup>2</sup>PAK, TO-220 and SO-8 surface mount packages and in the industry standard TO-220 package.
- New TMOS V fifth generation of Motorola Power MOSFET technology. This is a new processing technique that more than doubles the present cell density of our MOSFET devices.
- New Micro8 package is the smallest power MOSFET surface mount package.
- New EZFET™ surface mount power MOSFETs incorporate back to back zener diodes across the gate-to-source to enhance ESD protection.
- New IGBTs with high short circuit capability in TO-220, TO-247 and TO-264 packages.

The following new advances have been made in the area of packaging technology.

- New SO-8 (MiniMOS) and SOT-223 packages to the surface mount portfolio.
- New High Power packages capable of housing very large die and higher power dissipation are now available in the TO-264 (formerly TO-3PBL) and SOT-227B (Isotop) packages.
- New D<sup>3</sup>PAK package allows the highest power dissipation of any standard, plastic surface-mount power semiconductor.

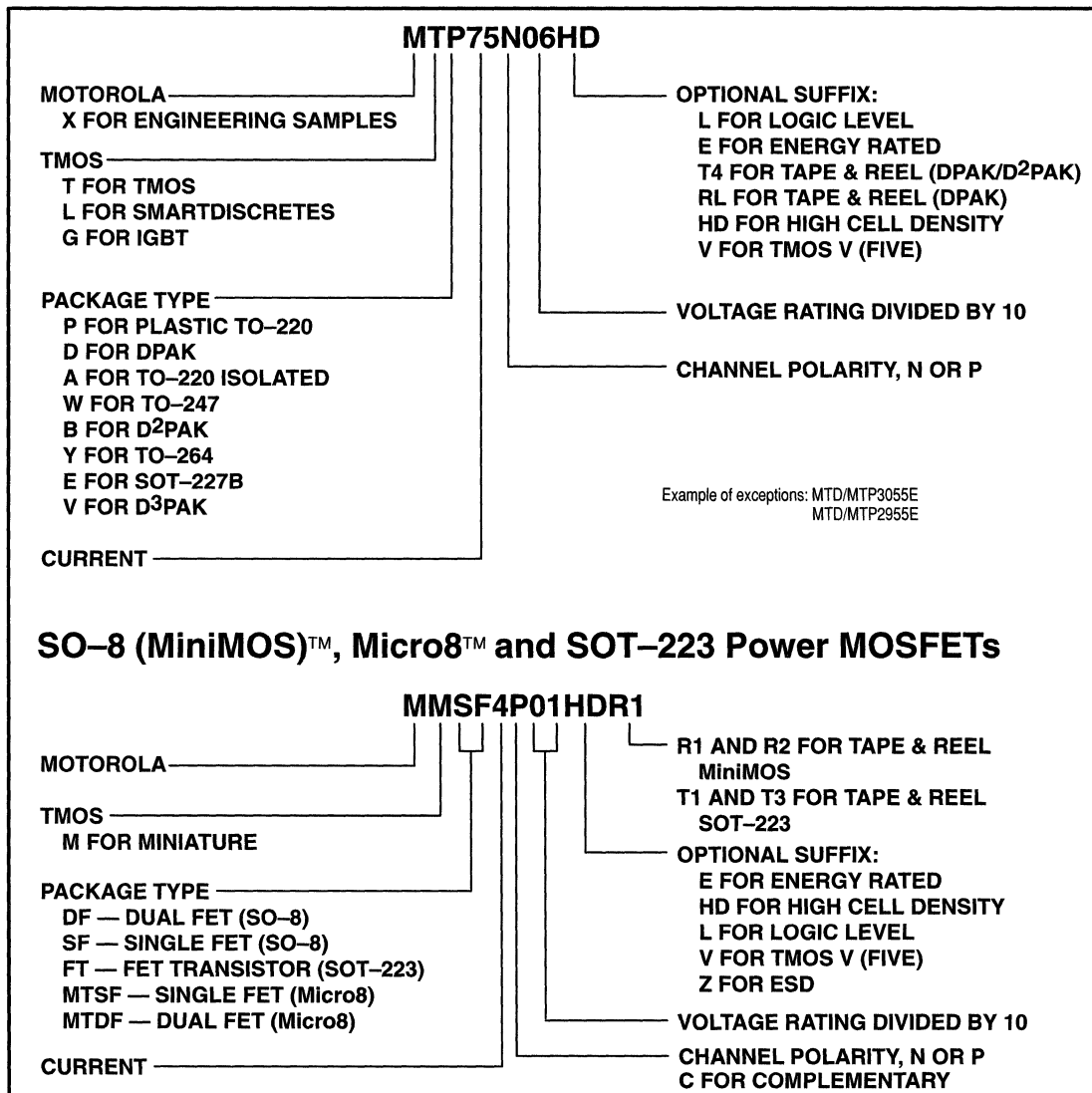
	<b>Page</b>
TMOS Power MOSFETs . . . . .	5.4-1
TMOS Power MOSFETs Numbering System . . . . .	5.4-2
HDTMOS™ Power MOSFETs . . . . .	5.4-3
TMOS V . . . . .	5.4-5
SMARTDISCRETES Products . . . . .	5.4-7
N-Channel MOSFETs . . . . .	5.4-8
SO-8 MiniMOS . . . . .	5.4-8
SO-8 EZFET . . . . .	5.4-9
Micro8 . . . . .	5.4-9
SOT-223 . . . . .	5.4-9
DPAK . . . . .	5.4-10
D <sup>2</sup> PAK . . . . .	5.4-11
D <sup>3</sup> PAK . . . . .	5.4-12
TO-220AB . . . . .	5.4-13
TO-247 . . . . .	5.4-15
TO-264 . . . . .	5.4-16
P-Channel MOSFETs . . . . .	5.4-17
SO-8 MiniMOS . . . . .	5.4-17
Micro8 . . . . .	5.4-17
SOT-223 . . . . .	5.4-18
DPAK . . . . .	5.4-18
D <sup>2</sup> PAK . . . . .	5.4-19
TO-220AB . . . . .	5.4-19
Logic Level MOSFETs . . . . .	5.4-20
SOT-223 . . . . .	5.4-20
DPAK . . . . .	5.4-20
D <sup>2</sup> PAK . . . . .	5.4-21
TO-220AB . . . . .	5.4-21
Insulated Gate Bipolar Transistors (IGBTs) . . . . .	5.4-22
N-Channel . . . . .	5.4-22
Ignition IGBTs . . . . .	5.4-22
Standard and Copackaged IGBTs . . . . .	5.4-22



# TMOS Power MOSFETs

## TMOS Power MOSFETs Numbering System

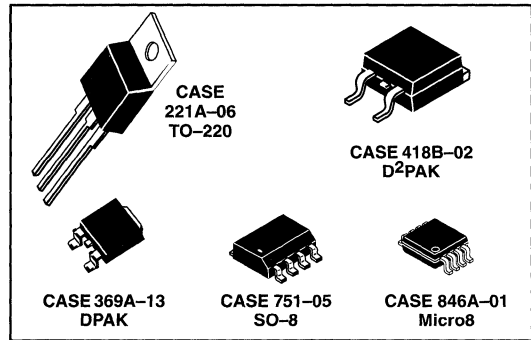
Wherever possible, Motorola has used the following numbering systems for TMOS power MOSFET products.





# HDTMOS Power MOSFETs

## N and P-Channel



HDTMOS Technology is a design technique that reduces the on-resistance contribution in virtually every portion of the power FET. The aggressive six million cells per square inch design is easily manufactured using wafer fabrication techniques that Motorola has used for several years to manufacture highly successful 8-bit microcontrollers.

HDTMOS devices are designed for use in low voltage, high speed switching applications where power efficiency is important. Typical applications are dc-dc converters and power management in portable and battery powered products such as computers, printers, cellular and cordless phones. They can also be used for low voltage motor controls in mass storage products such as disk drives and tape drives.

Table 1. High Power

V <sub>(BR)DSS</sub> (V)	R <sub>DS(on)</sub> @ V <sub>GS</sub>			ID (A)	Motorola Part Number	Package Type
	10 V (mΩ)	5 V (mΩ)	2.7 V (mΩ)			
60	45	—	—	20	<i>MTD20N06HD</i> <sup>(4)</sup>	DPAK
	—	45	—	20	<i>MTD20N06HDL</i> <sup>(4)</sup>	DPAK
	—	150	—	15	<i>MTD20P06HDL</i> <sup>(4)(5)</sup>	DPAK
	10	—	—	75	<i>MTB75N06HD</i> <sup>(4)</sup>	D <sup>2</sup> PAK
	14	—	—	60	<i>MTB60N06HD</i> <sup>(4)</sup>	D <sup>2</sup> PAK
	10	—	—	75	<i>MTP75N06HD</i>	TO-220
	14	—	—	60	<i>MTP60N06HD</i>	TO-220
50	9.50	—	—	75	<i>MTP75N05HD</i>	TO-220
	9.50	—	—	75	<i>MTB75N05HD</i> <sup>(4)</sup>	D <sup>2</sup> PAK
30	—	35	—	20	<i>MTD20N03HDL</i> <sup>(4)</sup>	DPAK
	—	99	—	19	<i>MTD20P03HDL</i> <sup>(4)(5)</sup>	DPAK
	6.0	7.5	—	75	<i>MTB75N03HDL</i> <sup>(4)</sup>	D <sup>2</sup> PAK
	—	30	—	50	<i>MTB50P03HDL</i> <sup>(4)(5)</sup>	D <sup>2</sup> PAK
	6.0	7.5	—	75	<i>MTP75N03HDL</i>	TO-220
	—	30	—	50	<i>MTP50P03HDL</i> <sup>(5)</sup>	TO-220

(4) Available in tape and reel — add T4 suffix to part number.

(5) Indicates P-Channel

Devices listed in bold, italic are Motorola preferred devices.

## HDTMOS Power MOSFETs (continued)

**Table 2. SOIC — COMPLEMENTARY, N and P–Channel**

V <sub>(BR)DSS</sub> (V)	R <sub>DS(on)</sub> @ V <sub>GS</sub>			I <sub>D</sub> (A)	Device (5)	Package Type	P <sub>D</sub> (3) (Watts) Max
	10 V (mΩ)	4.5 V (mΩ)	2.7 V (mΩ)				
50	300	500	—	1.5	<i>MMDF1N05E</i>	SO-8	1.5
30	200	300	—	2	<i>MMDF2P03HD</i>	SO-8	1.5
	100	110	—	3	<i>MMSF3P03HD</i>	SO-8	1.5
	70/200(11)	75/300(11)	—	2	<i>MMDF2C03HD</i>	SO-8	1.5
	70	75	—	2.8	<i>MMDF3N03HD</i>	SO-8	1.5
	40	50	—	5	<i>MMSF5N03HD</i>	SO-8	1.5
20	250	400	—	2	<i>MMSF2P02E</i>	SO-8	1.5
	250	400	—	2	<i>MMDF2P02E</i>	SO-8	1.5
	160	180	—	2	<i>MMDF2P02HD</i>	SO-8	1.5
	100/250(11)	200/400(11)	—	2	<i>MMDF2C02E</i>	SO-8	1.5
	100	200	—	2	<i>MMDF2N02E</i>	SO-8	1.5
	90/160(11)	100/180(11)	—	2	<i>MMDF2C02HD</i>	SO-8	1.5
	90	100	—	3	<i>MMDF3N02HD</i>	SO-8	1.5
	75	95	—	3	<i>MMSF3P02HD</i>	SO-8	1.5
	25	40	—	5	<i>MMSF5N02HD</i>	SO-8	1.5
12	—	180	220	2	<i>MMDF2P01HD</i>	SO-8	1.5
	—	100	110	4	<i>MMSF4P01HD</i>	SO-8	1.5
	—	45/180(11)	55/220(11)	2	<i>MMDF2C01HD</i>	SO-8	1.5
	—	45	55	4	<i>MMDF4N01HD</i>	SO-8	1.5

(3) Power rating when mounted on an FR-4 glass epoxy printed circuit board with the minimum recommended footprint.

(5) Available in tape and reel only — R1 suffix = 500/reel, R2 suffix = 2500/reel.

(11) N–Channel/P–Channel R<sub>DS(on)</sub>

**Table 3. EZFET**

V <sub>(BR)DSS</sub> (Volts) Min	Device	Description	R <sub>DS(on)</sub> (mΩ) @ V <sub>GS</sub> (Volts) Max		I <sub>D</sub> (cont) Amps	V <sub>GS</sub> (Volts) Max	Package
20	<i>MMSF3P02Z</i>	Single P–Channel	75	10	3	±15	SO-8
	90		4.5				
	<i>MMSF4P01Z</i>	Single N–Channel	70	4.5	4	±8	
	90		2.7				
<i>MMSF6N01Z</i>	Dual N–Channel	25	4.5	6			
30		2.7					
30	<i>MMDF4N01Z</i>	Dual N–Channel	45	4.5	4		
			55	2.7			
30	<i>MMSF5N03Z</i>	Single P–Channel	30	10	5	±15	
			40	4.5			

**Table 4. Micro8**

V <sub>(BR)DSS</sub> (Volts) Min	R <sub>DS(on)</sub> (mΩ) Max	V <sub>GS</sub> (Volts)	I <sub>D</sub> (cont) Amps	Device	Product Description
20	190	2.7	2	<i>MTSF1P02HD</i>	Single P–Channel
20	200	2.7	1.5	<i>MTDF1N02HD</i>	Dual N–Channel
30	75	4.5	3	<i>MTSF3N03HD</i>	Single N–Channel
30	225	4.5	1.5	<i>MTDF1N03HD</i>	Dual N–Channel

Devices listed in bold, italic are Motorola preferred devices.



## TMOS V

### Motorola Introduces Fifth Generation TMOS Technology

Power Products Division introduces a new technology in the low voltage TMOS transistor family. This new generation technology is currently referred to as TMOS V. It is revolutionary rather than evolutionary.

The TMOS V technology will more than double the present cell density of our TMOS Power MOSFETs. This new technology will result in a tighter overall distribution of electrical parameters and optimizes the performance of our 50 and 60 volt portfolio.

This is a high cell density process of the future that will produce a new line of industry standard devices. Power transistors can now be built with the same high resolution/small geometry MOS fabrication technology that is standard in Motorola's ASIC, microprocessor and Memory Wafer Fabs.

**Table 1. TMOS V — DPAK N-Channel**

$V_{(BR)DSS}$ (Volts) Min	$R_{DS(on)}$ (Ohms) Max	@ $I_D$ (Amps)	Device	$I_D$ (cont) Amps	$P_D$ (Watts) Max
60	0.150	6	<i>MTD3055V</i> <sup>(4)</sup>	12	1.75 <sup>(3)</sup>
	0.180	6	<i>MTD3055VL</i> <sup>(2)(4)</sup>	12	1.75 <sup>(3)</sup>
	0.120	7.5	<i>MTD15N06V</i> <sup>(4)</sup>	15	1.75 <sup>(3)</sup>
	0.120	7.5	<i>MTD15N06VL</i> <sup>(2)(4)</sup>	15	1.75 <sup>(3)</sup>
	0.100	10	<i>MTD20N06V</i> <sup>(4)</sup>	20	1.75 <sup>(3)</sup>

**Table 2. TMOS V — TO-220AB N-Channel**

$V_{(BR)DSS}$ (Volts) Min	$R_{DS(on)}$ (Ohms) Max	@ $I_D$ (Amps)	Device	$I_D$ (cont) Amps	$P_D$ (Watts) Max
60	0.150	6	<i>MTP3055V</i>	12	48 <sup>(1)</sup>
	0.180	6	<i>MTP3055VL</i> <sup>(2)</sup>	12	48 <sup>(1)</sup>
	0.120	7.5	<i>MTP15N06V</i>	15	55 <sup>(1)</sup>
	0.120	7.5	<i>MTP15N06VL</i> <sup>(2)</sup>	15	65 <sup>(1)</sup>
	0.100	10	<i>MTP20N06V</i>	20	65 <sup>(1)</sup>
	0.040	16	<i>MTP36N06V</i>	32	90 <sup>(1)</sup>
	0.050	15	<i>MTP30N06VL</i> <sup>(2)</sup>	30	90 <sup>(1)</sup>
	0.028	21	<i>MTP50N06V</i>	42	125 <sup>(1)</sup>
	0.032	21	<i>MTP50N06VL</i> <sup>(2)</sup>	42	125 <sup>(1)</sup>
	0.024	26	<i>MTP52N06V</i>	52	135 <sup>(1)</sup>
	0.028	26	<i>MTP52N06VL</i> <sup>(2)</sup>	52	135 <sup>(1)</sup>

(1)  $T_C = 25^\circ\text{C}$

(2) Indicates logic level

(3) Power rating when mounted on an FR-4 glass epoxy printed circuit board with the minimum recommended footprint.

(4) Available in tape and reel — add T4 suffix to part number.

Devices listed in bold, italic are Motorola preferred devices.

## TMOS V (continued)

**Table 3. TMOS V — D<sup>2</sup>PAK N-Channel**

V <sub>(BR)DSS</sub> (Volts) Min	R <sub>DS(on)</sub> (Ohms) Max	@ I <sub>D</sub> (Amps)	Device	I <sub>D</sub> (cont) Amps	P <sub>D</sub> (Watts) Max
60	0.120	7.5	<i>MTB15N06V</i> <sup>(4)</sup>	15	3.0 <sup>(3)</sup>
	0.120	7.5	<i>MTB15N06VL</i> <sup>(2)(4)</sup>	15	3.0 <sup>(3)</sup>
	0.100	10	<i>MTB20N06V</i> <sup>(4)</sup>	20	3.0 <sup>(3)</sup>
	0.040	16	<i>MTB36N06V</i> <sup>(4)</sup>	32	3.0 <sup>(3)</sup>
	0.050	15	<i>MTB30N06VL</i> <sup>(2)(4)</sup>	30	3.0 <sup>(3)</sup>
	0.028	21	<i>MTB50N06V</i> <sup>(4)</sup>	42	3.0 <sup>(3)</sup>
	0.032	21	<i>MTB50N06VL</i> <sup>(2)(4)</sup>	42	3.0 <sup>(3)</sup>
	0.024	26	<i>MTB52N06V</i> <sup>(4)</sup>	52	3.0 <sup>(3)</sup>
0.028	26	<i>MTB52N06VL</i> <sup>(2)(4)</sup>	52	3.0 <sup>(3)</sup>	

**Table 4. TMOS V — SOIC-8**

V <sub>(BR)DSS</sub> (Volts) Min	R <sub>DS(on)</sub> (Ohms) Max	@ I <sub>D</sub> (Amps)	Device	I <sub>D</sub> (cont) Amps	P <sub>D</sub> (Watts) Max
60	0.150	0.85	<i>MMDF3055V</i> <sup>(4)</sup>	1.7	1.8 <sup>(3)</sup>
	0.180	0.75	<i>MMDF3055VL</i> <sup>(2)(4)</sup>	1.5	1.8 <sup>(3)</sup>

**Table 5. TMOS V — SOT-223**

V <sub>(BR)DSS</sub> (Volts) Min	R <sub>DS(on)</sub> (Ohms) Max	@ I <sub>D</sub> (Amps)	Device	I <sub>D</sub> (cont) Amps	P <sub>D</sub> (Watts) Max
60	0.150	0.85	<i>MMFT3055V</i> <sup>(4)</sup>	1.7	0.96 <sup>(3)</sup>
	0.180	0.75	<i>MMFT3055VL</i> <sup>(2)(4)</sup>	1.5	0.96 <sup>(3)</sup>

**Table 6. TMOS V — P-Channel**

V <sub>(BR)DSS</sub> (Volts) Min	R <sub>DS(on)</sub> (Ohms) Max	@ I <sub>D</sub> (Amps)	Device	I <sub>D</sub> (cont) Amps	P <sub>D</sub> (Watts) Max
60	0.450	2.5	<i>MTD5P06V</i> <sup>(4)</sup>	5	1.75 <sup>(3)</sup>
	0.450	2.5	<i>MTP5P06V</i>	5	40 <sup>(1)</sup>
	0.300	6	<i>MTD2955V</i> <sup>(4)</sup>	12	1.75 <sup>(3)</sup>
	0.300	6	<i>MTP2955V</i>	12	55 <sup>(1)</sup>
	0.120	11.5	<i>MTB23P06V</i> <sup>(4)</sup>	23	3.0 <sup>(3)</sup>
	0.120	11.5	<i>MTP23P06V</i>	23	90 <sup>(1)</sup>
	0.080	15	<i>MTP30P06V</i>	30	125 <sup>(1)</sup>
	0.080	15	<i>MTB30P06V</i> <sup>(4)</sup>	30	3.0 <sup>(3)</sup>

(1) T<sub>C</sub> = 25°C

(2) Indicates logic level

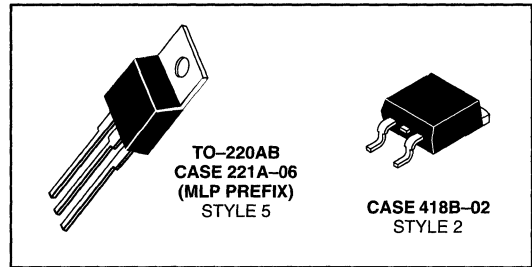
(3) Power rating when mounted on an FR-4 glass epoxy printed circuit board with the minimum recommended footprint.

(4) Available in tape and reel — add T4 suffix to part number.

Devices listed in bold, italic are Motorola preferred devices.



# SMARTDISCRETES Products



From a standard power MOSFET process, several active and passive elements can be obtained that provide on-chip protection to the basic power device. Such elements require only a small increase in silicon area and/or the addition of one masking layer to the process. The resulting device exhibits significant improvements in ruggedness and reliability and a system cost reduction. These SMARTDISCRETES™ functions can now provide an economical alternative to smart power ICs for power applications requiring low on-resistance, high voltage and high current.

These devices make up a series of “smart” power devices that automatically clamp spikes in automotive ignition systems and guard against ESD. The devices feature a logic level IGBT (Insulated Gate Bipolar Transistor) with integral active collector clamp and ESD gate protection and are designed primarily as ignition coil drivers to withstand high current in a pulsed mode without latching.

**Table 1. Ignition IGBTs**

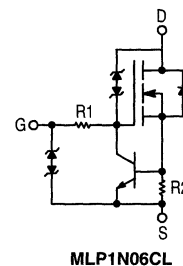
BV <sub>CES</sub> (Volts) Clamped	V <sub>CE(on)</sub> @ 10 A	Device	P <sub>D</sub> (1) (Watts) Max	Package
140 V	1.8	<b>MGP20N14CL</b>	150	TO-220AB
350 V	1.8	<b>MGP20N35CL</b> <b>MGB20N35CL</b>	150 2.5(3)(4)	TO-220AB D <sup>2</sup> PAK
400 V	1.8	<b>MGP20N40CL</b> <b>MGB20N40CL</b>	150 2.5(3)(4)	TO-220AB D <sup>2</sup> PAK

(1) T<sub>C</sub> = 25°C

(3) Power rating when mounted on an FR-4 glass epoxy printed circuit board with the minimum recommended footprint.

(4) DPAK and D<sup>2</sup>PAK packages available in tape and reel — add T4 suffix to part number.

The MLP1N06CL is a SMARTDISCRETES device that has integrated on-chip current limit capability, drain-to-source voltage clamping and gate voltage protection. The logic level processing allows operation of this device at half of the gate-to-source (5 volts) voltage of the conventional MOSFETs and can now be driven directly from CMOS or TTL logic drivers. This integration of technologies results in an intelligent, monolithic power circuit that offers a reduced parts count and improved reliability by replacing resistors, diodes, a bipolar transistor and a MOSFET with one device all of which are packaged in a TO-220AB package.



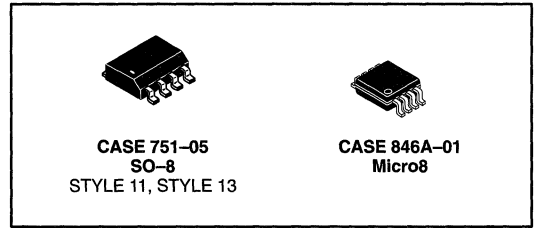
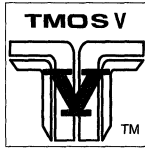
**Table 2. TO-220AB — MLP1N06CL**

V <sub>(BR)DSS</sub> (Volts) Min	R <sub>DS(on)</sub> (Ohms) Max	I <sub>D</sub> (Amps)	Device	I <sub>D</sub> (cont) Amps	P <sub>D</sub> (1) (Watts) Max
60 Clamped Voltage	0.75	1	<b>MLP1N06CL</b>	Current Limited	40
62 Clamped Voltage	0.4	2	MLP2N06CL	Current Limited	40

(1) T<sub>C</sub> = 25°C

(3) Power rating when mounted on an FR-4 glass epoxy printed circuit board with the minimum recommended footprint.

Devices listed in bold, italic are Motorola preferred devices.



## N-Channel

### SO-8 MiniMOS™ and Micro8 Surface Mount Products

MiniMOS devices are an advanced series of power MOSFETs which utilize Motorola's High Cell Density HDTMOS process. These miniature surface mount MOSFETs feature ultra low  $R_{DS(on)}$  and true logic level performance.

MiniMOS devices are designed for use in low voltage, high speed switching applications where power efficiency is important. Typical applications are dc-dc converters and power management in portable and battery powered products such as computers, printers, cellular and cordless phones. They can also be used for low voltage motor controls in mass storage products such as disk drives and tape drives.

- Ultra Low  $R_{DS(on)}$  Provides Higher Efficiency and Extends Battery Life
- Logic Level Gate Drive — Can Be Driven by Logic ICs
- Miniature SO-8 Surface Mount Package — Saves Board Space
- Diode Is Characterized for Use In Bridge Circuits
- Diode Exhibits High Speed, with Soft Recovery
- $I_{DSS}$  and  $V_{DS(on)}$  Specified at Elevated Temperature
- Avalanche Energy Specified

Table 1. SO-8 Products — N-Channel

V(BR)DSS (V)	RDS(on) @ VGS			ID (A)	Device(5)	Package Type	PD(3) (Watts) Max
	10 V (mΩ)	4.5 V (mΩ)	2.7 V (mΩ)				
50	300	500	—	1.5	<b><i>MMDF1N05E</i></b>	SO-8	1.5
30	40	50	—	5	<b><i>MMSF5N03HD</i></b>	SO-8	1.5
	70	75	—	2.8	<b><i>MMDF3N03HD</i></b>	SO-8	1.5
	70/200(11)	75/300	—	2	<b><i>MMDF2C03HD</i></b>	SO-8	1.5
20	25	40	—	5	<b><i>MMSF5N02HD</i></b>	SO-8	1.5
	90	100	—	3	<b><i>MMDF3N02HD</i></b>	SO-8	1.5
	100	200	—	2	<b><i>MMDF2N02E</i></b>	SO-8	1.5
	90/160(11)	100/180(11)	—	2	<b><i>MMDF2C02HD</i></b>	SO-8	1.5
	100/250(11)	200/400(11)	—	2	<b><i>MMDF2C02E</i></b>	SO-8	1.5
12	—	45	55	4	<b><i>MMDF4N01HD</i></b>	SO-8	1.5
	—	45/180(11)	55/220(11)	2	<b><i>MMDF2C01HD</i></b>	SO-8	1.5

(3) Power rating when mounted on an FR-4 glass epoxy printed circuit board with the minimum recommended footprint.

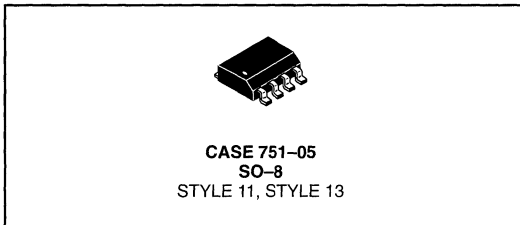
(5) Available in tape and reel only — R1 suffix = 500/reel, R2 suffix = 2500/reel.

(11) N-Channel/P-Channel  $R_{DS(on)}$

Devices listed in bold, italic are Motorola preferred devices.



## N-Channel (continued)



## N-Channel

### SO-8 EZFET™ — Power MOSFETs with Zener Gate Protection

- New Family of Low  $R_{DS(on)}$  MOSFETs with monolithic back-to-back zener diodes across the gate to source.
- HDTMOS™ Technology (High Cell Density TMOS)
- Extremely Low  $R_{DS(on)}$  provides higher efficiency and increased battery life in portable applications

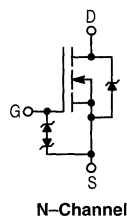


Table 2. EZFET

$V_{(BR)DSS}$ (Volts) Min	Device	Description	$R_{DS(on)}$ (m $\Omega$ ) Max	@ $V_{GS}$ (Volts)	$I_D$ (cont) Amps	$V_{GS}$ (Volts) Max	Package
20	<b><i>MMSF6N01Z</i></b>	Single N-Channel	25	4.5	6	$\pm 8$	SO-8
	<b><i>MMDF4N01Z</i></b>	Dual N-Channel	45	4.5	4		
			30	2.7			
			55	2.7			

Table 3. Micro8

$V_{(BR)DSS}$ (Volts) Min	$R_{DS(on)}$ (m $\Omega$ ) Max	@ $V_{GS}$ (Volts)	$I_D$ (cont) Amps	Device	Product Description
20	200	2.7	1.5	<b><i>MTDF1N02HD</i></b>	Dual N-Channel
30	75	4.5	3	<b><i>MTSF3N03HD</i></b>	Single N-Channel
30	225	4.5	1.5	<b><i>MTDF1N03HD</i></b>	Dual N-Channel

## SOT-223 Medium Power MOSFETs Surface Mount Products

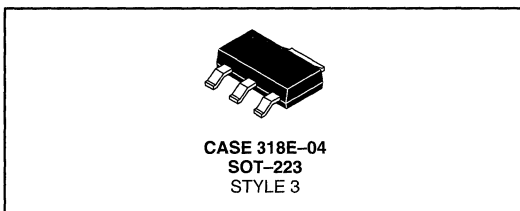


Table 4. SOT-223 Medium Power TMOS FETs — N-Channel

$V_{(BR)DSS}$ (Volts) Min	$R_{DS(on)}$ (Ohms) Max	@ $I_D$ (Amps)	Device <sup>(12)</sup>	$I_D$ (cont) Amps	$P_D$ <sup>(1)</sup> (Watts) Max	Applications
100	0.30	0.5	<b><i>MMFT1N10E</i></b>	1	0.8 <sup>(3)</sup>	dc-dc Converters Power Supplies Motor Controls, Disk Drives
60	0.18	0.75	<b><i>MMFT3055EL</i></b> <sup>(2)</sup>	1.5		
	0.15	0.85	<b><i>MMFT3055E</i></b>	1.7		
20	0.15	1	<b><i>MMFT2N02EL</i></b> <sup>(2)</sup>	2		

(1)  $T_C = 25^\circ\text{C}$

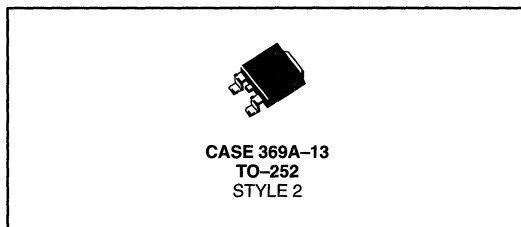
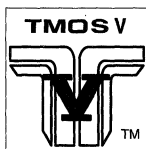
(2) Indicates logic level

(3) Power rating when mounted on an FR-4 glass epoxy printed circuit board with the minimum recommended footprint.

(12) Available in tape and reel only — T1 suffix = 1000/reel, T3 suffix = 4000/reel.

Devices listed in bold, italic are Motorola preferred devices.

## N-Channel (continued)



## N-Channel

### DPAK Surface Mount Products

Table 5. DPAK — N-Channel

V(BR)DSS (Volts) Min	R <sub>DS(on)</sub> (Ohms) Max	@	I <sub>D</sub> (Amps)	Device <sup>(4)</sup>	I <sub>D</sub> (cont) Amps	P <sub>D</sub> <sup>(1)</sup> (Watts) Max
800	12		0.5	<i>MTD1N80E</i>	1	1.75 <sup>(3)</sup>
600	8		0.5	<i>MTD1N60E</i>	1	
500	5		0.5	<i>MTD1N50E</i>	1	
	3.60		1	<i>MTD2N50E</i>	2	
400	3.50		1	<i>MTD2N40E</i>	2	
250	1.40		1.5	<i>MTD3N25E</i>	3	
	1		2.5	<i>MTD5N25E</i>	5	
200	1.20		2	<i>MTD4N20E</i>	4	
	0.70		3	<i>MTD6N20E</i>	6	
150	0.30		3	MTD6N15	6	
100	0.60		2.5	<i>MTD5N10E</i>	5	
	0.40		3	<i>MTD6N10E</i>	6	
	0.25		4.5	<i>MTD9N10E</i>	9	
	0.22		5	<i>MTD10N10EL</i> <sup>(2)</sup>	10	
60	0.18		6	<i>MTD3055VL</i> <sup>(2)</sup>	12	
	0.15		6	<i>MTD3055V</i>	12	
	0.12		4	<i>MTD8N06E</i>	8	
	0.12		7.5	<i>MTD15N06V</i>	15	
	0.045		10	<i>MTD20N06HD</i>	20	
	0.045		10	<i>MTD20N06HDL</i> <sup>(2)</sup>	20	
50	0.10		5	<i>MTD10N05E</i>	10	
30	0.035		10	<i>MTD20N03HDL</i> <sup>(2)</sup>	20	

(1) T<sub>C</sub> = 25°C

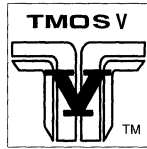
(2) Indicates logic level

(3) Power rating when mounted on an FR-4 glass epoxy printed circuit board with the minimum recommended footprint.

(4) Available in tape and reel — add T4 suffix to part number.

Devices listed in bold, italic are Motorola preferred devices.

## N-Channel (continued)



CASE 418B-02  
STYLE 2

## N-Channel

### D<sup>2</sup>PAK Surface Mount Products

Table 6. D<sup>2</sup>PAK — N-Channel

V(BR)DSS (Volts) Min	RDS(on) (Ohms) Max	@	I <sub>D</sub> (Amps)	Device (4)	I <sub>D</sub> (cont) Amps	P <sub>D</sub> (1) (Watts) Max
1200	5		1.5	<i>MTB3N120E</i>	3	2.5(3)
1000	9		0.5	<i>MTB1N100E</i>	1	
	4		1.5	<i>MTB3N100E</i>	3	
800	3		2	<i>MTB4N80E</i>	4	
600	1.20		3	<i>MTB6N60E</i>	6	
500	0.80		4	<i>MTB8N50E</i>	8	
400	0.55		5	<i>MTB10N40E</i>	10	
250	0.50		4.5	<i>MTB9N25E</i>	9	
	0.25		8	<i>MTB16N25E</i>	16	
200	0.16		10	<i>MTB20N20E</i>	20	
100	0.060		16.5	<i>MTB33N10E</i>	33	
60	—		—	<i>MTB15N06V</i>	—	
	0.05		15	<i>MTB30N06EL</i> (2)	30	
	0.04		16	<i>MTB36N06V</i>	36	
	0.032		21	<i>MTB50N06VL</i>	42	
	0.028		21	<i>MTB50N06V</i>	42	
	0.014		30	<i>MTB60N06HD</i>	60	
	0.01		37.5	<i>MTB75N06HD</i>	75	
50	0.0095		37.5	<i>MTB75N05HD</i>	75	
30	0.0075		37.5	<i>MTB75N03HDL</i> (2)	75	

(1) T<sub>C</sub> = 25°C

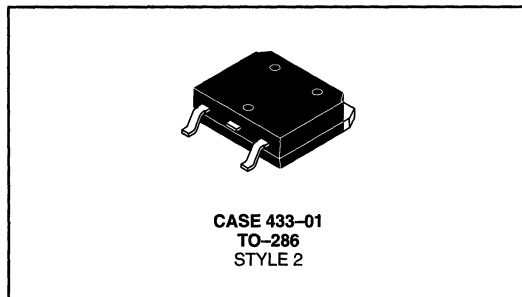
(2) Indicates logic level

(3) Power rating when mounted on an FR-4 glass epoxy printed circuit board with the minimum recommended footprint.

(4) Available in tape and reel — add T4 suffix to part number.

Devices listed in bold, italic are Motorola preferred devices.

## N-Channel (continued)



## N-Channel

### D<sup>3</sup>PAK

- D<sup>3</sup>PAK is a high power surface mount package designed to accommodate die which is too large for a D<sup>2</sup>PAK.
  - Utilized for Size 5, Size 6 or larger MOSFET and IGBT.
  - Used for dual die IGBT and diode combination.
- 24 mm Tape and Reel, 500 units per 13' reel.
- D<sup>3</sup>PAK is thermal characterized for use on FR-4 and IMS board materials.
- Applications:
  - Surface mount motor drives
  - Power supplies both AC/DC and DC/DC

Table 7. D<sup>3</sup>PAK — N-Channel

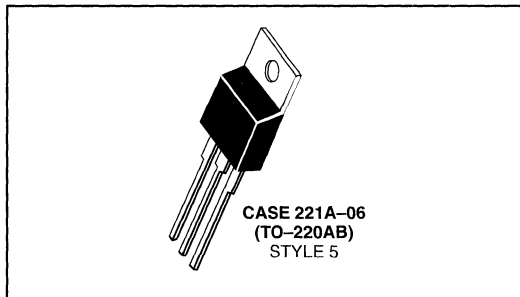
V <sub>(BR)DSS</sub> (Volts) Min	R <sub>DS(on)</sub> (Ohms) Max	@	I <sub>D</sub> (Amps)	Device(4)	I <sub>D</sub> (cont) Amps	P <sub>D</sub> (1) (Watts) Max
1000	1.50		3	<i>MTV6N100E</i>	6	178
	1.30		5	<i>MTV10N100E</i>	10	250
500	0.320		8	<i>MTV16N50E</i>	16	250
	0.240		10	<i>MTV20N50E</i>	20	250
	0.200		12.5	<i>MTV25N50E</i>	25	250
250	0.065		16	<i>MTV32N05E</i>	32	250
200	0.075		16	<i>MTV32N20E</i>	32	180

(1) T<sub>C</sub> = 25°C

(4) Available in tape and reel — add RL suffix to part number.

Devices listed in bold, italic are Motorola preferred devices.

## N-Channel (continued)



## N-Channel

### TO-220AB

Table 8. TO-220AB — N-Channel

$V_{(BR)DSS}$ (Volts) Min	$R_{DS(on)}$ (Ohms) Max	@	$I_D$ (Amps)	Device	$I_D$ (cont) Amps	$P_D^{(1)}$ (Watts) Max
1200	5.0		1.5	<i>MTP3N120E</i>	3	125
1000	9		0.5	<i>MTP1N100E</i>	1	75
	4.0		1.5	<i>MTP3N100E</i>	3	125
800	3		2	<i>MTP4N80E</i>	4	
600	8		0.5	<i>MTP1N60E</i>	1	50
	3.80		1	<i>MTP2N60E</i>	2	
	2.20		1.5	<i>MTP3N60E</i>	3	75
	1.20		3	<i>MTP6N60E</i>	6	125
500	5		0.5	<i>MTP1N50E</i>	1	50
	3.60		1	<i>MTP2N50E</i>	2	75
	3		1.5	<i>MTP3N50E</i>	3	50
	1.50		2	<i>MTP4N50E</i>	4	75
	0.80		4	<i>MTP8N50E</i>	8	125
400	3.50		1	<i>MTP2N40E</i>	2	50
	1.80		2	<i>MTP4N40E</i>	4	50
	1		2.5	<i>MTP5N40E</i>	5	75
	0.55		5	<i>MTP10N40E</i>	10	125
250	1.4		1	<i>MTP3N25E</i>	3	40
	0.5		4.5	<i>MTP9N25E</i>	9	75
	0.25		8	<i>MTP16N25E</i>	16	125
200	0.70		3.5	<i>MTP7N20E</i>	7	75
	0.16		10	<i>MTP20N20E</i>	20	125
100	0.25		5	<i>MTP10N10E</i>	10	75
	0.22		5	<i>MTP10N10EL</i>	10	40
	0.16		6	<i>MTP12N10E</i>	12	75
	0.070		13.5	<i>MTP27N10E</i>	27	125
	0.060		16.5	<i>MTP33N10E</i>	33	150

<sup>(1)</sup>  $T_C = 25^\circ\text{C}$

Devices listed in bold, italic are Motorola preferred devices.

## N-Channel (continued)

**Table 8. TO-220AB — N-Channel (continued)**

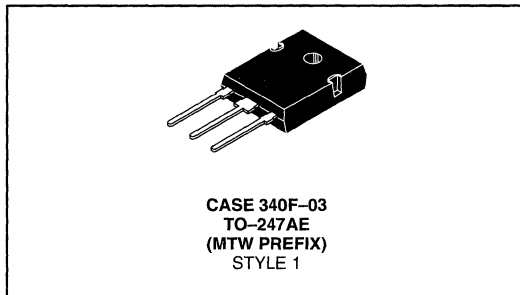
V <sub>(BR)DSS</sub> (Volts) Min	R <sub>DS(on)</sub> (Ohms) Max	@	I <sub>D</sub> (Amps)	Device	I <sub>D</sub> (cont) Amps	P <sub>D</sub> <sup>(1)</sup> (Watts) Max
60	0.18		6	<i>MTP3055VL</i> <sup>(2)</sup>	12	48
	0.15		6	<i>MTP3055V</i>	12	
	0.12		7.5	<i>MTP15N06V</i>	15	60
	0.12		7.5	<i>MTP15N06VL</i>	15	65
	0.10		10	<i>MTP20N06V</i>	20	
	0.05		15	<i>MTP30N06VL</i> <sup>(2)</sup>	30	90
	0.04		18	<i>MTP36N06V</i>	32	
	0.032		25	<i>MTP50N06VL</i> <sup>(2)</sup>	50	150
	0.028		25	<i>MTP50N06V</i>	50	
	0.028		26	<i>MTP52N06VL</i>	52	135
	0.024		26	<i>MTP52N06V</i>	52	
	0.014		30	<i>MTP60N06HD</i>	60	150
	0.01		37.5	<i>MTP75N06HD</i>	75	
50	0.10		7.5	<i>MTP15N05EL</i> <sup>(2)</sup>	15	75
	0.0095		37.5	<i>MTP75N05HD</i>	75	150
25	0.0075		37.5	<i>MTP75N03HDL</i> <sup>(2)</sup>	75	

<sup>(1)</sup> T<sub>C</sub> = 25°C

<sup>(2)</sup> Indicates logic level

Devices listed in bold, italic are Motorola preferred devices.

## N-Channel (continued)



## N-Channel

### TO-247 Isolated Mounting Hole

The Motorola portfolio of TO-247 devices has new on-resistance specifications on many industry standard devices with  $R_{DS(on)}$  reductions up to 25%.

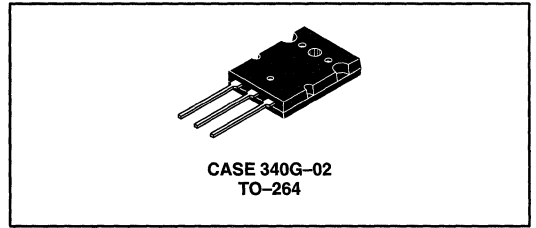
Table 9. TO-247 — N-Channel

$V_{(BR)DSS}$ (Volts) Min	$R_{DS(on)}$ (Ohms) Max	@	$I_D$ (Amps)	Device	$I_D$ (cont) Amps	$P_D^{(1)}$ (Watts) Max
1000	1.50		3	<i>MTW6N100E</i>	6	180
	1.30		5	<i>MTW10N100E</i>	10	250
800	1		3.5	<i>MTW7N80E</i>	7	180
600	0.50		4	<i>MTW8N60E</i>	8	180
500	0.32		7	<i>MTW14N50E</i>	14	180
	0.24		10	<i>MTW20N50E</i>	20	250
400	0.24		8	<i>MTW16N40E</i>	16	180
	0.16		12	<i>MTW24N40E</i>	24	250
250	0.10		16	<i>MTW32N25E</i>	32	250
200	0.075		16	<i>MTW32N20E</i>	32	180
150	0.065		17.5	<i>MTW35N15E</i>	35	180
100	0.035		22.5	<i>MTW45N10E</i>	45	180

(1)  $T_C = 25^\circ\text{C}$

Devices listed in bold, italic are Motorola preferred devices.

## N-Channel (continued)



## N-Channel

### TO-264 High Power Products

The TO-264 package is a new addition to the Motorola portfolio of high power packages. This package is capable of a power dissipation of 300 Watts and it achieves a low on-resistance with a single die. Lead spacing is compatible to the TO-247 package.

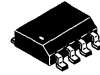
**Table 10. TO-264 High Power Products — N-Channel**

$V_{(BR)DSS}$ (Volts) Min	$R_{DS(on)}$ (Ohms) Max	@	$I_D$ (Amps)	Device	$I_D$ (cont) Amps	$P_D^{(1)}$ (Watts) Max
600	0.21		12.5	<i>MTY25N60E</i>	25	300
500	0.26		10	<i>MTY20N50E</i>	20	
	0.15		15	<i>MTY30N50E</i>	30	
200	0.028		27.5	<i>MTY55N20E</i>	55	
100	0.011		50	<i>MTY100N10E</i>	100	

(1)  $T_C = 25^\circ\text{C}$

Devices listed in bold, italic are Motorola preferred devices.





CASE 751-05  
SO-8  
STYLE 11, STYLE 13



CASE 846A-01  
Micro8

## P-Channel

### SO-8 (MiniMOS) and Micro8 Surface Mount Products

#### Multiple Chip TMOS Products in SOIC Surface Mount Packages

MiniMOS devices are an advanced series of power MOSFETs which utilize Motorola's High Cell Density HDTMOS process. These miniature surface mount MOSFETs feature ultra low  $R_{DS(on)}$  and true logic level performance.

MiniMOS devices are designed for use in low voltage, high speed switching applications where power efficiency is important. Typical applications are dc-dc converters and power management in portable and battery powered products such as computers, printers, cellular and cordless phones. They can also be used for low voltage motor controls in mass storage products such as disk drives and tape drives.

Table 1. SO-8 Products — P-Channel

$V_{(BR)DSS}$ (V)	$R_{DS(on)}$ @ $V_{GS}$			$I_D$ (A)	Device(5)	Package Type	$P_D^{(3)}$ (Watts) Max
	10 V (m $\Omega$ )	4.5 V (m $\Omega$ )	2.7 V (m $\Omega$ )				
30	100	110	—	3	<b>MMSF3P03HD</b>	SO-8	1.5
	200	300	—	2	<b>MMDF2P03HD</b>	SO-8	1.5
20	75	95	—	3	<b>MMSF3P02HD</b>	SO-8	1.5
	160	180	—	2	<b>MMDF2P02HD</b>	SO-8	1.5
	250	400	—	2	<b>MMDF2P02E</b>	SO-8	1.5
	250	400	—	2	<b>MMSF2P02E</b>	SO-8	1.5
12	—	100	110	4	<b>MMSF4P01HD</b>	SO-8	1.5
	—	180	220	2	<b>MMDF2P01HD</b>	SO-8	1.5

(3) Power rating when mounted on an FR-4 glass epoxy printed circuit board with the minimum recommended footprint.

(5) Available in tape and reel only — R1 suffix = 500/reel, R2 suffix = 2500/reel.

Table 2. Micro8

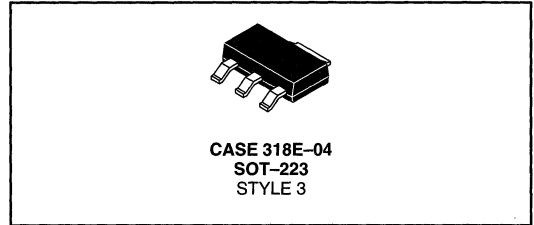
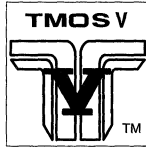
$V_{(BR)DSS}$ (Volts) Min	$R_{DS(on)}$ (m $\Omega$ ) Max	@	$V_{GS}$ (Volts)	$I_D$ (cont) Amps	Device	Product Description
20	190		2.7	2	<b>MTSF1P02HD</b>	Single P-Channel

Table 3. EZFET

$V_{(BR)DSS}$ (Volts) Min	Device	Description	$R_{DS(on)}$ (m $\Omega$ ) Max	$V_{GS}$ (Volts)	$I_D$ (cont) Amps	$V_{GS}$ (Volts) Max	Package
20	<b>MMSF3P02Z</b>	Single P-Channel	75	10	3	$\pm 15$	SO-8
			90	4.5			
	<b>MMSF4P01Z</b>		70	4.5	4	$\pm 8$	
			90	2.7			

Devices listed in bold, italic are Motorola preferred devices.

## P-Channel (continued)



## P-Channel

### SOT-223 Medium Power MOSFETs Surface Mount Products

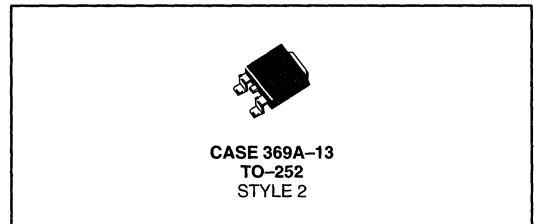
Table 4. SOT-223 Medium Power TMOS FETs — P-Channel

$V_{(BR)DSS}$ (Volts) Min	$R_{DS(on)}$ (Ohms) @ Max	$I_D$ (Amps)	Device <sup>(12)</sup>	$I_D$ (cont) Amps	$P_D^{(1)}$ (Watts) Max	Application
60	0.30	0.6	<b><i>MMFT2955E</i></b>	1.2	0.8 <sup>(3)</sup>	dc-dc Converters Power Supplies Motor Controls, Disk Drives

<sup>(1)</sup>  $T_C = 25^\circ\text{C}$

<sup>(3)</sup> Power rating when mounted on an FR-4 glass epoxy printed circuit board with the minimum recommended footprint.

<sup>(12)</sup> Available in tape and reel only — T1 suffix = 1000/reel, T3 suffix = 4000/reel.



### DPAK Surface Mount Products

Table 5. DPAK — P-Channel

$V_{(BR)DSS}$ (Volts) Min	$R_{DS(on)}$ (Ohms) Max	@	$I_D$ (Amps)	Device <sup>(4)</sup>	$I_D$ (cont) Amps	$P_D^{(1)}$ (Watts) Max
500	15.0		0.5	<b><i>MTD1P50E</i></b>	1	1.75 <sup>(3)</sup>
100	0.66		3	<b><i>MTD6P10E</i></b>	6	
60	0.55		2.5	<b><i>MTD5P06E</i></b>	5	
	—		—	<b><i>MTD5P06V</i></b>	—	
	0.15		10	<b><i>MTD20P06HDL</i></b> <sup>(2)</sup>	20	
30	0.099		10	<b><i>MTD20P03HDL</i></b> <sup>(2)</sup>	19	

<sup>(1)</sup>  $T_C = 25^\circ\text{C}$

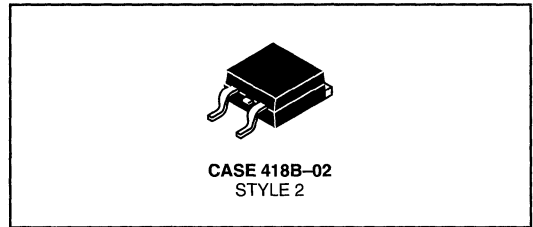
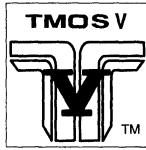
<sup>(2)</sup> Indicates logic level

<sup>(3)</sup> Power rating when mounted on an FR-4 glass epoxy printed circuit board with the minimum recommended footprint.

<sup>(4)</sup> Available in tape and reel — add T4 suffix to part number.

Devices listed in bold, italic are Motorola preferred devices.

## P-Channel (continued)



## P-Channel

### D<sup>2</sup>PAK Surface Mount Products

Table 6. D<sup>2</sup>PAK — P-Channel

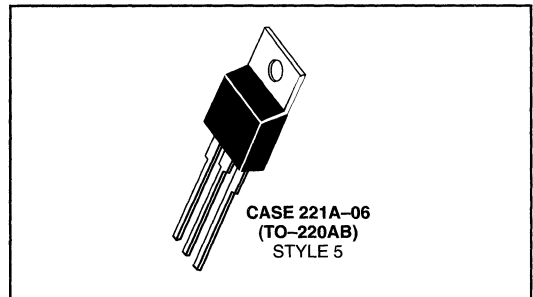
V <sub>(BR)DSS</sub> (Volts) Min	R <sub>DS(on)</sub> (Ohms) Max	@	I <sub>D</sub> (Amps)	Device (4)	I <sub>D</sub> (cont) Amps	P <sub>D</sub> (1) (Watts) Max
500	6		1	<i>MTB2P50E</i>	2	2.5(3)
60	0.12		11.5	<i>MTB23P06E</i>	23	
30	0.025		25	<i>MTB50P03HDL</i> (2)	50	

(1) T<sub>C</sub> = 25°C

(2) Indicates logic level

(3) Power rating when mounted on an FR-4 glass epoxy printed circuit board with the minimum recommended footprint.

(4) Available in tape and reel — add T4 suffix to part number.



## TO-220AB

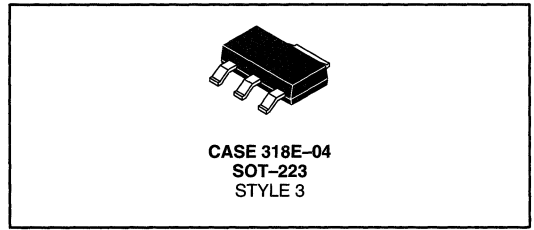
Table 7. TO-220AB — P-Channel

V <sub>(BR)DSS</sub> (Volts) Min	R <sub>DS(on)</sub> (Ohms) Max	@	I <sub>D</sub> (Amps)	Device	I <sub>D</sub> (cont) Amps	P <sub>D</sub> (1) (Watts) Max
500	6		1	<i>MTP2P50E</i>	2	75
200	1		3	<i>MTP6P20E</i>	6	
100	0.30		6	<i>MTP12P10</i>	12	88
60	0.45		2.5	<i>MTP5P06V</i>	5	40
	0.30		6	<i>MTP2955V</i>	12	60
	0.12		11.5	<i>MTP23P06V</i>	23	125
	0.08		15	<i>MTD30P06V</i>	30	125
30	0.025		25	<i>MTP50P03HDL</i> (2)	50	150

(1) T<sub>C</sub> = 25°C

(2) Indicates logic level

Devices listed in bold, italic are Motorola preferred devices.



## Logic Level — N-Channel

### SOT-223 Medium Power MOSFETs Surface Mount Products

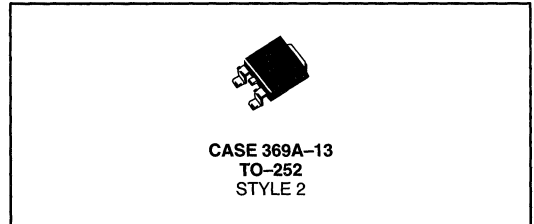
Table 1. SOT-223 Medium Power TMOS FETs — Logic Level

$V_{(BR)DSS}$ (Volts) Min	$R_{DS(on)}$ (Ohms) @ Max	$I_D$ (Amps)	Device(12)	$I_D$ (cont) Amps	$P_D^{(1)}$ (Watts) Max	Application
60	0.18	0.75	<b><i>MMFT3055EL</i></b>	1.5	0.8 <sup>(3)</sup>	dc-dc Converters Power Supplies Motor Controls, Disk Drives
20	0.15	1	<b><i>MMFT2N02EL</i></b>	2		

(1)  $T_C = 25^\circ\text{C}$

(3) Power rating when mounted on an FR-4 glass epoxy printed circuit board with the minimum recommended footprint.

(12) Available in tape and reel only — T1 suffix = 1000/reel, T3 suffix = 4000/reel.



## DPAK — N and P-Channel Surface Mount Products

Table 2. DPAK — Logic Level

$V_{(BR)DSS}$ (Volts) Min	$R_{DS(on)}$ (Ohms) Max	@	$I_D$ (Amps)	Device(4)	$I_D$ (cont) Amps	$P_D^{(1)}$ (Watts) Max
100	0.22		5	<b><i>MTD10N10EL</i></b>	10	1.75 <sup>(3)</sup>
60	0.12		7.5	<b><i>MTD15N06V</i></b>	15	
	0.18		6	<b><i>MTD3055VL</i></b>	12	
	0.15		10	<b><i>MTD20P06HDL</i></b> <sup>(5)</sup>	20	
	0.045		10	<b><i>MTD20N06HDL</i></b>	20	
30	0.099		10	<b><i>MTD20P03HDL</i></b> <sup>(5)</sup>	19	
	0.035		10	<b><i>MTD20N03HDL</i></b>	20	

(1)  $T_C = 25^\circ\text{C}$

(2) Indicates logic level

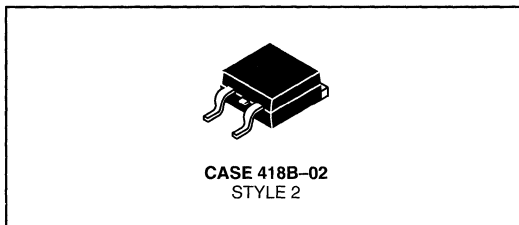
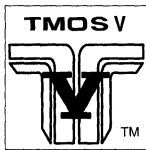
(3) Power rating when mounted on an FR-4 glass epoxy printed circuit board with the minimum recommended footprint.

(4) Available in tape and reel — add T4 suffix to part number.

(5) Indicates P-Channel

Devices listed in bold, italic are Motorola preferred devices.

## Logic Level (continued)



## Logic Level

### D2PAK — N and P-Channel Surface Mount Products

Table 3. D2PAK — Logic Level

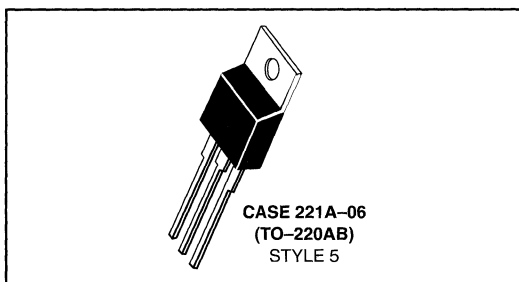
V <sub>(BR)DSS</sub> (Volts) Min	R <sub>DS(on)</sub> (Ohms) Max	@	I <sub>D</sub> (Amps)	Device <sup>(4)</sup>	I <sub>D</sub> (cont) Amps	P <sub>D</sub> <sup>(1)</sup> (Watts) Max
60	0.05		15	<i>MTB30N06VL</i>	30	2.5 <sup>(3)</sup>
	0.032		21	<i>MTB50N06VL</i>	42	
30	0.025		25	<i>MTB50P03HDL</i> <sup>(5)</sup>	50	
	0.0075		37.5	<i>MTB75N03HDL</i>	75	

(1) T<sub>C</sub> = 25°C

(3) Power rating when mounted on an FR-4 glass epoxy printed circuit board with the minimum recommended footprint.

(4) Available in tape and reel — add T4 suffix to part number.

(5) Indicates P-Channel



### TO-220AB — N and P-Channel

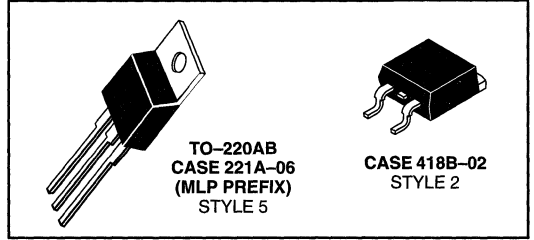
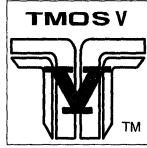
Table 4. TO-220AB — Logic Level

V <sub>(BR)DSS</sub> (Volts) Min	R <sub>DS(on)</sub> (Ohms) Max	@	I <sub>D</sub> (Amps)	Device	I <sub>D</sub> (cont) Amps	P <sub>D</sub> <sup>(1)</sup> (Watts) Max
100	0.22		5	<i>MTP10N10EL</i>	10	75
60	0.18		6	<i>MTP3055EL</i>	12	48
	0.18		6	<i>MTP3055VL</i>	12	
	0.05		15	<i>MTP30N06EL</i>	30	75
	0.05		15	<i>MTP30N06VL</i>	30	90
	0.028		25	<i>MTP50N06EL</i>	50	150
	0.032		21	<i>MTP50N06VL</i>	42	125
	0.028		26	<i>MTP52N06VL</i>	50	135
50	0.12		7.5	<i>MTP15N06VL</i>	15	150
	0.10		7.5	<i>MTP15N05EL</i>	15	
	0.032		25	<i>MTP50N05EL</i>	50	
30	0.025		25	<i>MTP50P03HDL</i> <sup>(2)</sup>	50	150
	0.0075		37.5	<i>MTP75N03HDL</i>	75	

(1) T<sub>C</sub> = 25°C

(2) Indicates P-Channel

Devices listed in bold, italic are Motorola preferred devices.



## N-Channel

### Insulated Gate Bipolar Transistors (IGBTs)

These devices make up a series of "smart" power devices that automatically clamp spikes in automotive ignition systems and guard against ESD. The devices feature a logic level IGBT (Insulated Gate Bipolar Transistor) with integral active collector clamp and ESD gate protection and are designed primarily as ignition coil drivers to withstand high current in a pulsed mode without latching.

Table 1. N-Channel Ignition IGBTs

BV <sub>CES</sub> (Volts) Clamped	V <sub>CE(on)</sub> @ 10 A	Device	P <sub>D</sub> (1) (Watts) Max	Package
140 V	1.8	<i>MGP20N14CL</i>	150	TO-220AB
350 V	1.8	<i>MGP20N35CL</i> <i>MGB20N35CL</i>	150 2.5(3)(4)	TO-220AB D <sup>2</sup> PAK
400 V	1.8	<i>MGP20N40CL</i> <i>MGB20N40CL</i>	150 2.5(3)(4)	TO-220AB D <sup>2</sup> PAK

(1) T<sub>C</sub> = 25°C

(3) Power rating when mounted on an FR-4 glass epoxy printed circuit board with the minimum recommended footprint.

(4) DPAK and D<sup>2</sup>PAK packages available in tape and reel — add T4 suffix to part number.

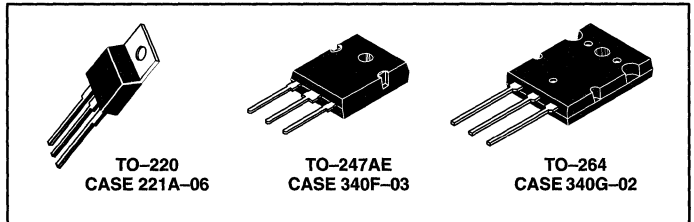


Table 2. N-Channel, Standard and Copackaged IGBTs

Device	BV <sub>CES</sub> (Volts)	I <sub>C</sub> @ 90°C (A)	V <sub>CE(on)</sub> @ I <sub>C</sub> (Volts) Max	P <sub>D</sub> (1) Watts	Package
<i>MGP5N60E</i>	600	5	2.06 A @ 1.5 A	62	TO-220
<i>MGP20N60</i>		20	2.9 V @ 10 A	142	TO-220
<i>MGW20N60D</i>					TO-247
<i>MGW30N60</i>		30	2.9 V @ 15 A	202	TO-247
<i>MGY30N60D</i>					TO-264
<i>MGY40N60</i>		40	2.8 V @ 20 A	260	TO-264
<i>MGY40N60D</i>					TO-264
<i>MGW12N120</i>	1200	12	3.37 V @ 5 A	123	TO-247
<i>MGW12N120D</i>					TO-247
<i>MGY25N120</i>		25	3.24 V @ 12.5 A	212	TO-264

(1) T<sub>C</sub> = 25°C

Devices listed in bold, italic are Motorola preferred devices.

# Bipolar Power Transistors

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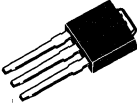

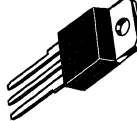
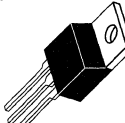

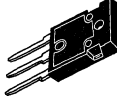
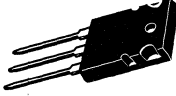
## In Brief . . .

Motorola's broad line of Bipolar Power Transistors includes discrete and Darlington transistors in a variety of packages from the popular surface mount DPAK at 1.75 watts to the 250 watt TO-3 and TO-264. New products include the MJE/MJF 18000 series for lamp ballast and power supplies, MJW16212 — a new 1500 V deflection transistor for video monitor applications, and high performance audio output devices in the TO-264 package. We have the broadest line of Bipolar Power Transistors in the industry and the Motorola commitment to quality and total customer satisfaction to go with them.

	<b>Page</b>
Bipolar Power Transistors . . . . .	5.5-2
Selection by Package . . . . .	5.5-2
Plastic TO-220AB . . . . .	5.5-3
Plastic TO-218 Type . . . . .	5.5-6
Plastic TO-247 Type . . . . .	5.5-7
Large Plastic TO-264 . . . . .	5.5-8
Plastic TO-225AA Type (Formerly TO-126 Type) . . . . .	5.5-8
DPAK — Surface Mount Power Packages . . . . .	5.5-10
Metal TO-204AA (Formerly TO-3), TO-204AE . . . . .	5.5-11
Audio . . . . .	5.5-15
Electronic Lamp Ballasts . . . . .	5.5-16

# Bipolar Power Transistors

## Selection by Package

Package	I <sub>C</sub> Range (Amps)	V <sub>CE</sub> Range (Volts)	P <sub>D</sub> (Watts)	Page #	
	TO-204AA (TO-3) CASE 1-07	4-30	40-1500	90-250	5.5-11
	TO-204AE CASE 197A	50-80	60-1000	150-300	5.5-11
	DPAK CASE 369	0.5-10	40-400	12.5-20	5.5-10
	DPAK CASE 369A	0.5-10	40-400	12.5-20	5.5-10
	TO-218 TYPE CASE 340D	5.0-25	60-1500	80-150	5.5-6
	TO-220AB CASE 221A-06	0.5-15	30-1800	30-125	5.5-3
	TO-225AA (TO-126 TYPE) CASE 77	0.3-5.0	25-400	12.5-40	5.5-8
	TO-247 TYPE CASE 340F	10-30	400-1500	125-180	5.5-7
	TO-264 CASE 340G	15-16	200-650	250	5.5-8



STYLE 1:  
 PIN 1. BASE  
 2. COLLECTOR  
 3. EMITTER  
 4. COLLECTOR

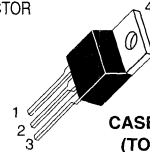


Table 1. Plastic TO-220AB

I <sub>C</sub> Cont Amps Max	V <sub>CEO(sus)</sub> Volts Min <sup>(8)</sup>	Device Type		h <sub>FE</sub> Min/Max	@ I <sub>C</sub> Amp	Resistive Switching			f <sub>T</sub> MHz Min	P <sub>D</sub> (Case) Watts @ 25°C
		NPN	PNP			t <sub>s</sub> μs Max	t <sub>f</sub> μs Max	@ I <sub>C</sub> Amp		
0.5	350	MJE2360T		15 min	0.1				10 typ	30
		<b>MJE2361T</b>		40 min	0.1				10 typ	30
1	100	TIP29C	TIP30C	15/75	1	0.6 typ	0.3 typ	1	3	30
	250	TIP47		30/150	0.3	2 typ	0.18 typ	0.3	10	40
	300	TIP48	MJE5730	30/150	0.3	2 typ	0.18 typ	0.3	10	40
	350	<b>TIP49</b>	<b>MJE5731</b>	30/150	0.3	2 typ	0.18 typ	0.3	10	40
	400	<b>TIP50</b>	<b>MJE5731A<sup>(7)</sup></b>	30/150	0.3	2 typ	0.18 typ	0.3	10	40
2	100	<b>TIP112<sup>(2)</sup></b>	<b>TIP117<sup>(2)</sup></b>	500 min	2	1.7 typ	1.3 typ	2	25 <sup>(1)</sup>	50
	400/700	<b>BUL44</b>		14/36	0.4	2.75 <sup>(3)</sup>	0.175 <sup>(3)</sup>	1	13 typ	50
	450/1000	<b>BUX85</b>		30	0.1	3.5	1.4	1	4	50
	450/1000	<b>MJE18002</b>		14/34	0.2	3 <sup>(3)</sup>	0.17 <sup>(3)</sup>	1	12 typ	40
	900/1800	<b>MJE1320</b>		3 min	1	4 typ	0.8 typ	1		80
3	80	BD241B	BD242B	25 min	1				3	40
	100	BD241C	BD242C	25 min	1				3	40
		<b>TIP31C</b>	<b>TIP32C</b>	25 min	1	0.6 typ	0.3 typ	1	3	40
	150		<b>MJE9780</b>	50/200	0.5				5 typ	40

(1) h<sub>FE</sub> @ 1 MHz

(2) Darlington

(3) Switching tests performed w/special application simulator circuit. See data sheet for details.

(7) V<sub>CEO</sub> = 375 V

(8) When 2 voltages are given, the format is V<sub>CEO(sus)</sub>/V<sub>CES</sub>.

Devices listed in bold, italic are Motorola preferred devices.

Table 1. Plastic TO-220AB (continued)

I <sub>C</sub> Cont Amps Max	V <sub>CEO(sus)</sub> Volts Min <sup>(8)</sup>	Device Type		h <sub>FE</sub> Min/Max	@ I <sub>C</sub> Amp	Resistive Switching			f <sub>T</sub> MHz Min	P <sub>D</sub> (Case) Watts @ 25°C
		NPN	PNP			t <sub>s</sub> μs Max	t <sub>f</sub> μs Max	@ I <sub>C</sub> Amp		
4	40		<i>MJE1123</i>	45/100	4				5	75
	60	<i>MJE800</i> <sup>(2)</sup>	<i>MJE700</i> <sup>(2)</sup>	750 min	1.5				1 <sup>(1)</sup>	40
	80	<i>D44C12</i>	<i>D45C12</i>	40/120	0.2			1	40 typ	30
	400/700	<i>MJE13005</i>		6/30	3	3	0.7	3	4	60
5	100	<i>TIP122</i> <sup>(2)</sup>	<i>TIP127</i> <sup>(2)</sup>	1k min	3	1.5 typ	1.5 typ	4	4 <sup>(1)</sup>	75
	250	2N6497		10/75	2.5	1.8	0.8	2.5	5	80
	300	<i>2N6498</i>		10/75	2.5	1.8	0.8	2.5	5	80
	400/700	<i>BUL45</i>		14/34	0.3	1.7 <sup>(3)</sup>	0.15 <sup>(3)</sup>	1	12 typ	75
	450/1000	MJE16002		5 min	5	3	0.3	3		80
	450/850	<i>MJE16004</i>		7 min	5	2.7	0.35	3		80
	450/1000	<i>MJE18004</i>		14/34	0.3	1.7	0.15	1.0	13	75
	550/1200	<i>MJE18204</i>		18/35	0.5	2.75 <sup>(3)</sup>	0.2 <sup>(3)</sup>	2	12	75
6	80	<i>BD243B</i>	<i>BD244B</i>	15 min	3	0.4 typ	0.15 typ	3	3	65
	100	<i>BD243C</i>	<i>BD244C</i>	15 min	3	0.4 typ	0.15 typ	3	3	65
		<i>TIP41C</i>	<i>TIP42C</i>	15/75	3	0.4 typ	0.15 typ	3	3	65
	250/550	<i>MJE16204</i>		5 min	6	1.5 <sup>(2)</sup>	0.15 <sup>(2)</sup>	1	10	80
	400/700	<i>BUL146</i>		14/34	0.5	1.75 <sup>(3)</sup>	0.15 <sup>(3)</sup>	3	14 typ	100
	450/1000	<i>MJE18006</i>		14/34	0.5	3.2 <sup>(3)</sup>	0.13 <sup>(3)</sup>	3	14 typ	100
7	30	2N6288	2N6111	30/150	3	0.4 typ	0.15 typ	3	4	40
	50		2N6109	30/150	2.5	0.4 typ	0.15 typ	3	4	40
	70	<i>2N6292</i>	<i>2N6107</i>	30/150	2	0.4 typ	0.15 typ	3	4	40
	100	<i>BD801</i>	<i>BD802</i>	15 min	3				3	65
	150	BU407		30 min	1.5		0.75	5	10	60
	200	<i>BU406</i>		30 min	1.5		0.75	5	10	60
	450	<i>BU522B</i> <sup>(2)</sup>		250 min	2.5				7.5	75

(1) |h<sub>FE</sub>| @ 1 MHz

(2) Darlington

(3) Switching tests performed w/special application simulator circuit. See data sheet for details.

(7) V<sub>CEO</sub> = 375 V

(8) When 2 voltages are given, the format is V<sub>CEO(sus)</sub>/V<sub>CES</sub>.

Devices listed in bold, italic are Motorola preferred devices.

Table 1. Plastic TO-220AB (continued)

I <sub>C</sub> Cont Amps Max	V <sub>CEO(sus)</sub> Volts Min <sup>(8)</sup>	Device Type		hFE Min/Max	@ I <sub>C</sub> Amp	Resistive Switching			f <sub>T</sub> MHz Min	P <sub>D</sub> (Case) Watts @ 25°C
		NPN	PNP			t <sub>s</sub> μs Max	t <sub>f</sub> μs Max	@ I <sub>C</sub> Amp		
8	60	2N6043 <sup>(2)</sup>	2N6040 <sup>(2)</sup>	1k/10k	4	1.5 typ	1.5 typ	3	4 <sup>(1)</sup>	75
	80	<b>2N6044<sup>(2)</sup></b>	<b>2N6041<sup>(2)</sup></b>	1k/10k	4	1.5 typ	1.5 typ	3	4 <sup>(1)</sup>	75
		<b>BDX53B<sup>(2)</sup></b>	<b>BDX54B<sup>(2)</sup></b>	750 min	3				4 <sup>(1)</sup>	60
	100	<b>2N6045<sup>(2)</sup></b>	<b>2N6042<sup>(2)</sup></b>	1k/10k	3	1.5 typ	1.5 typ	3	4 <sup>(1)</sup>	75
		<b>BDX53C<sup>(2)</sup></b>	<b>BDX54C<sup>(2)</sup></b>	750 min	3					
		<b>TIP102<sup>(2)</sup></b>	<b>TIP107<sup>(2)</sup></b>	1k/20k	3	1.5 typ	1.5 typ	3	4 <sup>(1)</sup>	80
	120	MJE15028	MJE15029	20 min	4				30	50
	150	<b>MJE15030</b>	<b>MJE15031</b>	20 min	4				30	50
	200	<b>BU806<sup>(2)</sup></b>		100 min	5	0.55 typ	0.2 typ	5		60
	300/600	MJE5740 <sup>(2)</sup>		200 min	4	8 typ	2 typ	6	4	80
			MJE5850	15 min	2	2	0.5	4		80
	350	<b>MJE5741<sup>(2)</sup></b>		200 min	4	8 typ	2 typ	6		80
			<b>MJE5851</b>	15 min	2	2	0.5	4		80
		<b>MJE5742<sup>(2)</sup></b>		200 min	4	8 typ	2 typ	6		80
		<b>MJE13007</b>		5/30	5	3	0.7	5		80
		<b>MJE5852</b>	15 min	2	2	0.5	4		80	
400/650	<b>MJE16106</b>		6/22	8	2 typ	0.1 typ	5		100	
400/700	<b>BUL147</b>		14/34	1	2.5 <sup>(3)</sup>	0.18 <sup>(3)</sup>	2	14 typ	125	
450/1000	<b>MJE18008</b>		16/34	1	2.75 <sup>(3)</sup>	0.18 <sup>(3)</sup>	2	13 typ	125	
10	20		<b>BD808</b>	15 min	4				1.5	90
	60	D44H8	D45H8	40 min	4					50
		<b>MJE3055T</b>	<b>MJE2955T</b>	20/70	4					75
		<b>2N6387<sup>(2)</sup></b>	<b>2N6667<sup>(2)</sup></b>	1k/20k	5				20 <sup>(1)</sup>	65
	80	<b>BDX33B<sup>(2)</sup></b>	<b>BDX34B<sup>(2)</sup></b>	750 min	3				3	70
		<b>BD809</b>	<b>BD810</b>	15 min	4				1.5	90
		<b>2N6388<sup>(2)</sup></b>	<b>2N6668<sup>(2)</sup></b>	1k/20k	5				20 <sup>(1)</sup>	65
		D44H10	D45H10	20 min	4	0.5 typ	0.14 typ	5	50 typ	50
		<b>D44H11</b>	<b>D45H11</b>	40 min	4	0.5 typ	0.14 typ	5	50 typ	50

(1) h<sub>FEI</sub> @ 1 MHz

(2) Darlington

(3) Switching tests performed w/special application simulator circuit. See data sheet for details.

(7) V<sub>CEO</sub> = 375 V

(8) When 2 voltages are given, the format is V<sub>CEO(sus)</sub>/V<sub>CES</sub>.

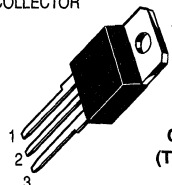
(9) Self protected Darlington

Devices listed in bold, italic are Motorola preferred devices.

**Table 1. Plastic TO–220AB (continued)**

I <sub>C</sub> Cont Amps Max	V <sub>CEO(sus)</sub> Volts Min <sup>(8)</sup>	Device Type		hFE Min/Max	@ I <sub>C</sub> Amp	Resistive Switching			f <sub>T</sub> MHz Min	P <sub>D</sub> (Case) Watts @ 25°C
		NPN	PNP			t <sub>s</sub> μs Max	t <sub>f</sub> μs Max	@ I <sub>C</sub> Amp		
10	100	<b><i>BDX33C</i></b> <sup>(2)</sup>	<b><i>BDX34C</i></b> <sup>(2)</sup>	750 min	3				3	70
	450/1000	<b><i>MJE18009</i></b>		14/34	1.5	2.75 <sup>(3)</sup>	0.2 <sup>(3)</sup>	3	12	150
12	400/700	<b><i>MJE13009</i></b>		6/30	8	3	0.7	8	4	100
15	80	<b><i>2N6488</i></b>	<b><i>2N6491</i></b>	20/150	5	0.6 typ	0.3 typ	5	5	75
		<b><i>D44VH10</i></b>	<b><i>D45VH10</i></b>	20 min	4	0.5	0.09	8	50 typ	83
	100	<b><i>BDW42</i></b> <sup>(2)</sup>	<b><i>BDW47</i></b> <sup>(2)</sup>	1k min	5	1 typ	1.5 typ	5	4	85

STYLE 1:  
PIN 1. BASE  
2. COLLECTOR  
3. EMITTER  
4. COLLECTOR



**CASE 340D  
(TO–218 Type,  
SOT–93)**

**Table 2. Plastic TO–218 Type**

I <sub>C</sub> Cont Amps Max	V <sub>CEO(sus)</sub> Volts Min <sup>(8)</sup>	Device Type		hFE Min/Max	@ I <sub>C</sub> Amp	Resistive Switching			f <sub>T</sub> MHz Min	P <sub>D</sub> (Case) Watts @ 25°C
		NPN	PNP			t <sub>s</sub> μs Max	t <sub>f</sub> μs Max	@ I <sub>C</sub> Amp		
8	500/1000	<b><i>MJH16006A</i></b>		5 min	8	2.5	0.25	5		125
10	60	TIP140 <sup>(2)</sup>	TIP145 <sup>(2)</sup>	500 min	10	2.5 typ	2.5 typ	5	4 <sup>(1)</sup>	125
		TIP141 <sup>(2)</sup>	TIP146 <sup>(2)</sup>	500 min	10	2.5 typ	2.5 typ	5	4 <sup>(1)</sup>	125
	100	<b><i>BDV65B</i></b> <sup>(2)</sup>	<b><i>BDV64B</i></b> <sup>(2)</sup>	1k min	5					125
		TIP33C	TIP34C	20/100	3				3	80
		<b><i>TIP142</i></b> <sup>(2)</sup>	<b><i>TIP147</i></b> <sup>(2)</sup>	500 min	10	2.5 typ	2.5 typ	5	4 <sup>(1)</sup>	125
	400	<b><i>BU323AP</i></b> <sup>(2)</sup>		150/100	6	15	15	6		125
<b><i>MJH10012</i></b> <sup>(2)</sup>			100/2k	6	15	15	6		118	

<sup>(1)</sup>hFE<sub>1</sub> @ 1 MHz

<sup>(2)</sup>Darlington

<sup>(8)</sup>When 2 voltages are given, the format is V<sub>CEO(sus)</sub>/V<sub>CES</sub>.

Devices listed in bold, italic are Motorola preferred devices.

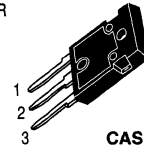
Table 2. Plastic TO-218 Type (continued)

I <sub>C</sub> Cont Amps Max	V <sub>CEO(sus)</sub> Volts Min <sup>(8)</sup>	Device Type		hFE Min/Max	@ I <sub>C</sub> Amp	Resistive Switching			f <sub>T</sub> MHz Min	P <sub>D</sub> (Case) Watts @ 25°C
		NPN	PNP			t <sub>s</sub> μs Max	t <sub>f</sub> μs Max	@ I <sub>C</sub> Amp		
15	60	<i>TIP3055</i>	<i>TIP2955</i>	5 min	10				2.5	80
	150	MJH11018 <sup>(2)</sup>	MJH11017 <sup>(2)</sup>	400/15k	10				3	150
	200	MJH11020 <sup>(2)</sup>	MJH11019 <sup>(2)</sup>	400/15k	10				3	150
	250	<b>MJH11022<sup>(2)</sup></b>	<b>MJH11021<sup>(2)</sup></b>	400/15k	10				3	150
	400	BUV48		8 min	10	2	0.4	10		150
	450	<b>BUV48A</b>		8 min	8	2	0.4	10		150
16	140	MJE4342	MJE4352	15 min	8	1.2 typ	1.2 typ	8	1	125
	160	<b>MJE4343</b>	<b>MJE4353</b>	15 min	8	1.2 typ	1.2 typ	8	1	125
20	60	MJH6282 <sup>(2)</sup>	MJH6285 <sup>(2)</sup>	750/18k	10				4	125
	100	<b>MJH6284<sup>(2)</sup></b>	<b>MJH6287<sup>(2)</sup></b>	750/18k	10				4	125
25	80	TIP35A	TIP36A	15/75	15	0.6 typ	0.3 typ	10	3	125
	100	<b>BD249C</b>	<b>BD250C</b>	10 min	15				3	125
		<b>TIP35C</b>	<b>TIP36C</b>	15/75	15	0.6 typ	0.3 typ	10	3	125

<sup>(2)</sup>Darlington

<sup>(8)</sup>When 2 voltages are given, the format is V<sub>CEO(sus)</sub>/V<sub>CES</sub>.

STYLE 2:  
PIN 1. BASE  
2. COLLECTOR  
3. EMITTER



CASE 340F  
(TO-247 Type)

Table 3. Isolated Mounting Hole — Plastic TO-247 Type

I <sub>C</sub> Cont Amps Max	V <sub>CEO(sus)</sub> Volts Min	V <sub>CES</sub> Volts Min	Device Type		hFE Min/Max	@ I <sub>C</sub> Amp	Resistive Switching			f <sub>T</sub> MHz Min	P <sub>D</sub> (Case) Watts @ 25°C
			NPN	PNP			t <sub>s</sub> μs Max	t <sub>f</sub> μs Max	@ I <sub>C</sub> Amp		
10	650	1500	<b>MJW16212</b>		4/10	10	4 <sup>(3)</sup>	0.5 <sup>(3)</sup>	5.5		150
	800	1500	<b>MJW16018</b>		4 min	5	4.5 typ	0.2 typ	5	3 typ	150
12	500	1200	<b>MJW16206</b>		5/13	10	2.25	0.25	6.5	3 typ	150
15	450	850	<b>MJW16010</b>		5 min	15	1.2 typ	0.2 typ	10		150
		850	<b>MJW16012</b>		7 min	15	0.9 typ	0.15 typ	10		150
	500	1000	<b>MJW16010A</b>		5 min	15	3	0.4	10		150

<sup>(3)</sup>Switching tests performed w/special application simulator circuit. See data sheet for details.

<sup>(10)</sup>Tested in Applications simulator: see Data Sheet.

Devices listed in bold, italic are Motorola preferred devices.

STYLE 2:  
 PIN 1. BASE  
 2. COLLECTOR  
 3. EMITTER

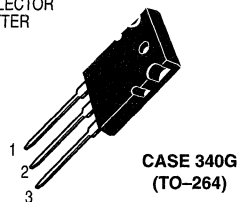


Table 4. Large Plastic TO-264

I <sub>C</sub> Cont Amps Max	V <sub>CEO(sus)</sub> Volts Min	Device Type		hFE Min/Max	@ I <sub>C</sub> Amp	Resistive Switching			f <sub>T</sub> MHz Min	P <sub>D</sub> (Case) Watts @ 25°C
		NPN	PNP			t <sub>s</sub> μs Max	t <sub>f</sub> μs Max	@ I <sub>C</sub> Amp		
15	200	<i>MJL3281A</i>	<i>MJL1302A</i>	60/175	0.1				30 typ	200
	650/1500	<i>MJL1621B</i>		4/11	12				2.5 typ	170
16	250	<i>MJL21194</i>	<i>MJL21193</i>	25/75	8				4	200

STYLE 1:  
 PIN 1. EMITTER  
 2. COLLECTOR  
 3. BASE

STYLE 3:  
 PIN 1. BASE  
 2. COLLECTOR  
 3. EMITTER

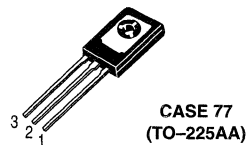


Table 5. Plastic TO-225AA Type (Formerly TO-126 Type)

I <sub>C</sub> Cont Amps Max	V <sub>CEO(sus)</sub> Volts Min	Device Type		hFE Min/Max	@ I <sub>C</sub> Amp	Resistive Switching			f <sub>T</sub> MHz Min	P <sub>D</sub> (Case) Watts @ 25°C
		NPN	PNP			t <sub>s</sub> μs Max	t <sub>f</sub> μs Max	@ I <sub>C</sub> Amp		
0.3	350	<i>MJE3439</i>		40/160	0.02				15	15
0.5	150	MJE341		25/200	0.05				15	20.8
	200	<i>MJE344</i>		30/300	0.05				15	20.8
	250	2N5655		30/250	0.1	3.5 typ	0.24 typ	0.1	10	20
		BD157		30/240	0.05					20
	300	<i>BD158</i>		30/240	0.05					20
<i>MJE340</i>		<i>MJE350</i>	30/240	0.05					20.8	
2N5656			30/250	0.1	3.5 typ	0.24 typ	0.1	10	20	

Devices listed in bold, italic are Motorola preferred devices.

Table 5. Plastic TO-225AA Type (Formerly TO-126 Type) (continued)

I <sub>C</sub> Cont Amps Max	V <sub>CEO</sub> (sus) Volts Min	Device Type		hFE Min/Max	@ I <sub>C</sub> Amp	Resistive Switching			f <sub>T</sub> MHz Min	P <sub>D</sub> (Case) Watts @ 25°C	
		NPN	PNP			t <sub>s</sub> μs Max	t <sub>f</sub> μs Max	@ I <sub>C</sub> Amp			
0.5	350	<b>2N5657</b>		30/250	0.1	3.5 typ	0.24 typ	0.1	10	20	
		<b>BD159</b>		30/240	0.05					20	
1	40	2N4921	2N4918	20/100	0.5	0.6 typ	0.3 typ	0.5	3	30	
	60	2N4922	2N4919	20/100	0.5	0.6 typ	0.3 typ	0.5	3	30	
	80	<b>2N4923</b>	<b>2N4920</b>	20/100	0.5	0.6 typ	0.3 typ	0.5	3	30	
1.5	45	<b>BD165</b>	<b>BD166</b>	15 min	0.5				6	20	
		BD135	BD136	40/250	0.15					12.5	
	60	BD137	BD138	40/250	0.15					12.5	
	80	<b>BD169</b>		15 min	0.5				6	20	
		<b>BD139</b>	<b>BD140</b>	40/250	0.15					12.5	
			<b>BD140-10</b>	63/160	0.15					12.5	
	300	MJE13002 <sup>(11)</sup>		5/25	1	4	0.7	1	5	40	
	400	<b>MJE13003</b> <sup>(11)</sup>		5/25	1	4	0.7	1	5	40	
2	80	<b>BD237</b>	<b>BD238</b>	25 min	1				3	25	
	100	<b>MJE270</b> <sup>(2)(11)</sup>	<b>MJE271</b> <sup>(2)(11)</sup>	1.5k min	0.12				6	15	
3	60	MJE181	MJE171	50/250	0.1	0.6 typ	0.12 typ	0.1	50	12.5	
	80	<b>BD179</b>	<b>BD180</b>	40/250	0.15				3	30	
		<b>MJE182</b>	<b>MJE172</b>	50/250	0.1	0.6 typ	0.12 typ	0.1	50	12.5	
200	<b>BUY49P</b>		30 min	0.5				25	20		
4	40	<b>MJE521</b>	<b>MJE371</b>	40 min	1					40	
	45	<b>BD437</b>	<b>BD438</b>	40 min	2				3	36	
			<b>BD776</b> <sup>(2)</sup>	750 min	2				20	15	
	60		<b>BD440</b>	25 min	2				3	36	
			<b>BD677</b> <sup>(2)</sup>	<b>BD678</b> <sup>(2)</sup>	750 min	1.5				40	
			<b>BD677A</b> <sup>(2)</sup>	<b>BD678A</b> <sup>(2)</sup>	750 min	2				40	
			<b>BD787</b>	<b>BD788</b>	20 min	2				50	15
			<b>BD777</b> <sup>(2)</sup>	<b>BD778</b> <sup>(2)</sup>	750 min	2				20	15
			<b>2N5191</b>	<b>2N5194</b>	25/100	1.5	0.4 typ	0.4 typ	1.5	2	40
			<b>MJE800</b> <sup>(2)</sup>	<b>MJE700</b> <sup>(2)</sup>	750 min	1.5				1 <sup>(1)</sup>	40
			<b>2N6038</b> <sup>(2)</sup>	<b>2N6035</b> <sup>(2)</sup>	750/18k	2	1.7 typ	1.2 typ	2	25	40
	80	<b>2N5192</b>	<b>2N5195</b>	25/100	1.5	0.4 typ	0.4 typ	1.5	2	40	
		<b>BD441</b>	<b>BD442</b>	15 min	2				3	36	
		<b>BD679</b> <sup>(2)</sup>	<b>BD680</b> <sup>(2)</sup>	750 min	1.5					40	
		<b>BD679A</b> <sup>(2)</sup>	<b>BD680A</b> <sup>(2)</sup>	750 min	2					40	
<b>BD789</b>		<b>BD790</b>	10 min	2				40	15		

(1) I<sub>hFE1</sub> @ 1 MHz  
 (2) Darlington  
 (11) Case 77, Style 3

Devices listed in bold, italic are Motorola preferred devices.

Table 5. Plastic TO-225AA Type (Formerly TO-126 Type) (continued)

I <sub>C</sub> Cont Amps Max	V <sub>CEO(sus)</sub> Volts Min	Device Type		h <sub>FE</sub> Min/Max	@ I <sub>C</sub> Amp	Resistive Switching			f <sub>T</sub> MHz Min	P <sub>D</sub> (Case) Watts @ 25°C
		NPN	PNP			t <sub>s</sub> μs Max	t <sub>f</sub> μs Max	@ I <sub>C</sub> Amp		
4	80	<b><i>BD779</i></b> (2)	<b><i>BD780</i></b> (2)	750 min	2				20	15
		MJE802(2)	MJE702(2)	750 min	1.5				1(1)	40
		<b><i>MJE803</i></b> (2)	<b><i>MJE703</i></b> (2)	750 min	2				1(1)	40
		<b><i>2N6039</i></b> (2)	<b><i>2N6036</i></b> (2)	750/18k	2	1.7 typ	1.2 typ	2	25	40
	100	<b><i>BD681</i></b> (2)	<b><i>BD682</i></b> (2)	750 min	1.5					40
		<b><i>BD791</i></b>	<b><i>BD792</i></b>	10 min	2				40	15
		<b><i>MJE243</i></b>	<b><i>MJE253</i></b>	40/120	0.2	0.15 typ	0.07 typ	2	40	15
5	25	<b><i>MJE200</i></b>	<b><i>MJE210</i></b>	45/180	2	0.13 typ	0.035 typ	2	65	15



STYLE 1:  
PIN 1. BASE  
2. COLLECTOR  
3. EMITTER  
4. COLLECTOR

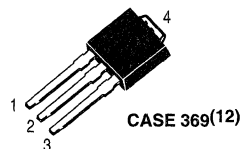


Table 6. DPAK – Surface Mount Power Packages

I <sub>C</sub> Cont Amps Max	V <sub>CEO(sus)</sub> Volts Min	Device Type		h <sub>FE</sub> Min/Max	@ I <sub>C</sub> Amp	Resistive Switching			f <sub>T</sub> MHz Min	P <sub>D</sub> (Case) Watts @ 25°C
		NPN	PNP			t <sub>s</sub> μs Max	t <sub>f</sub> μs Max	@ I <sub>C</sub> Amp		
0.5	300	<b><i>MJD340</i></b>	<b><i>MJD350</i></b>	30/240	0.05					15
1	250	MJD47		30/150	0.3	2	0.2	0.3	10	15
	375		<b><i>MJD5731</i></b>	TBD	TBD	TBD	TBD	TBD	TBD	TBD
	400	<b><i>MJD50</i></b>		30/150	0.3	2	0.2	0.3	10	15
1.5	400	<b><i>MJD13003</i></b>		5/25	1	4	0.7	1	4	15

(1)h<sub>FE</sub> @ 1 MHz

(2)Darlington

(12)Case 369-07 may be ordered by adding -1 suffix to part number.

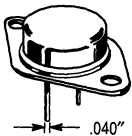
(13)Case 369A-13 may be ordered as tape and reel by adding a "T4" suffix; 2500 units/reel.

Devices listed in bold, italic are Motorola preferred devices.

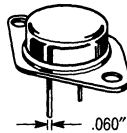


Table 6. DPAK – Surface Mount Power Packages (continued)

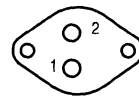
I <sub>C</sub> Cont Amps Max	V <sub>CEO(sus)</sub> Volts Min	Device Type		h <sub>FE</sub> Min/Max	@ I <sub>C</sub> Amp	Resistive Switching			f <sub>T</sub> MHz Min	P <sub>D</sub> (Case) Watts @ 25°C
		NPN	PNP			t <sub>s</sub> μs Max	t <sub>f</sub> μs Max	@ I <sub>C</sub> Amp		
2	100	<i>MJD112</i> (2)	<i>MJD117</i> (2)	1000 min	2	1.7	1.3	2	25(1)	20
3	40	MJD31	MJD32	10 min	1	0.6	0.3	1	3	15
	100	<i>MJD31C</i>	<i>MJD32C</i>	10 min	1	0.6	0.3	1	3	15
4	80	<i>MJD6039</i> (2)	<i>MJD6036</i> (2)	1k/12k	2	1.7	1.2	2	25	20
	100	<i>MJD243</i>	<i>MJD253</i>	40/180	0.2	0.16	0.04	1	40	12.5
5	25	<i>MJD200</i>	<i>MJD210</i>	45/180	2	0.15	0.04	2	65	12.5
6	100	<i>MJD41C</i>	<i>MJD42C</i>	15/75	3	0.4	0.15	3	3	20
8	80	<i>MJD44H11</i>	<i>MJD45H11</i>	40 min	4	0.5	0.14	5	50 typ	20
	100	<i>MJD122</i> (2)	<i>MJD127</i> (2)	1k/12k	4	1.5	2	4	4(1)	20
10	60	<i>MJD3055</i>	<i>MJD2955</i>	20/100	4	1.5	1.5	3	2	20
	80	<i>MJD44E3</i> (2)		1k min	5	2	0.5	10		20



CASE 1-07  
TO-204AA



CASE 197A TO-204AE  
(Used for high current types at end of  
table. See types w/footnote(16).)



STYLE 1:  
PIN 1. BASE  
2. EMITTER  
3. COLLECTOR

Table 7. Metal TO-204AA (Formerly TO-3), TO-204AE

I <sub>C</sub> Cont Amps Max	V <sub>CEO(sus)</sub> Volts Min(8)	Device Type		h <sub>FE</sub> Min/Max	@ I <sub>C</sub> Amp	Resistive Switching			f <sub>T</sub> MHz Min	P <sub>D</sub> (Case) Watts @ 25°C
		NPN	PNP			t <sub>s</sub> μs Max	t <sub>f</sub> μs Max	@ I <sub>C</sub> Amp		
4	200	MJ15018		30 min	1				20	150
	250	<i>MJ15020</i>	<i>MJ15021</i>	30 min	1				20	150
5	700/1500	<i>BU208A</i>		2.5 min	4.5	8 typ	0.4 typ	4.5	4 typ	90
8	60	MJ1000(2)		1k min	3					90
		2N6055(2)		750/18k	4	1.5 typ	1.5 typ	4	4(1)	100
	80	<i>MJ1001</i> (2)		1k min	3					90
		<i>2N6056</i> (2)		750/18k	4	1.5 typ	1.5 typ	4	4(1)	100

(1)h<sub>FE</sub> @ 1 MHz

(2)Darlington

(8)When 2 voltages are given, the format is V<sub>CEO(sus)</sub>/V<sub>CES</sub>.

(12)Case 369 may be ordered by adding -1 suffix to part number.

(13)Case 369A may be ordered as tape and reel by adding a "T4" suffix; 2500 units/reel.

Devices listed in bold, italic are Motorola preferred devices.

Table 7. Metal TO-204AA (Formerly TO-3), TO-204AE (continued)

I <sub>C</sub> Cont Amps Max	V <sub>CEO(sus)</sub> Volts Min <sup>(8)</sup>	Device Type		h <sub>FE</sub> Min/Max	@ I <sub>C</sub> Amp	Resistive Switching			f <sub>T</sub> MHz Min	PD (Case) Watts @ 25°C
		NPN	PNP			t <sub>s</sub> μs Max	t <sub>f</sub> μs Max	@ I <sub>C</sub> Amp		
10	60	2N3715	2N3791	30 min	3	0.3 typ	0.4 typ	5	4	150
		MJ3000 <sup>(2)</sup>	MJ2500 <sup>(2)</sup>	1k min	5					150
	80	2N3716	2N3792	30 min	3	0.3 typ	0.4 typ	5	4	150
		2N5878		20/100	4	1	0.8	4	4	150
		MJ3001 <sup>(2)</sup>	<b>MJ2501<sup>(2)</sup></b>	1k min	5					150
	140	2N3442		20/70	4					117
	250	<b>MJ15011</b>	<b>MJ15012</b>	20/100	2					200
	325	<b>MJ413</b>		20/80	0.5				2.5	125
		MJ423		30/90	1				2.5	125
	400	<b>BU323A<sup>(2)</sup></b>		150 min	6	7.5 typ	5.2 typ	6		175
<b>MJ10007<sup>(2)</sup></b>			30/300	5	1.5	0.5	5	10 <sup>(1)</sup>	150	
<b>MJ10012<sup>(2)</sup></b>			100/2k	6	15	15	6		175	
12	60	2N6057 <sup>(2)</sup>	2N6050 <sup>(2)</sup>	750/18k	6	1.6 typ	1.5 typ	6	4 <sup>(1)</sup>	150
	80	2N6058 <sup>(2)</sup>	2N6051 <sup>(2)</sup>	750/18k	6	1.6 typ	1.5 typ	6	4 <sup>(1)</sup>	150
	100	<b>2N6059<sup>(2)</sup></b>	<b>2N6052<sup>(2)</sup></b>	750/18k	6	1.6 typ	1.5 typ	6	4 <sup>(1)</sup>	150
15	60	<b>2N3055</b>	<b>MJ2955</b>	20/70	4	0.7 typ	0.3 typ	4	2.5	115
		<b>2N3055A</b>	<b>MJ2955A</b>	20/70	4				0.8	115
		2N6576 <sup>(2)</sup>		2k/20k	4	2	7	10	10-200 <sup>(1)</sup>	120
		2N5881	2N5879	20/100	6	1	0.8	6	4	160
	80	<b>2N5882</b>	<b>2N5880</b>	20/100	6	1	0.8	6	4	160
	90	2N6577 <sup>(2)</sup>		2k/20k	4	2	7	10	10-200 <sup>(1)</sup>	120
	120	<b>MJ15015</b>	<b>MJ15016</b>	20/70	4	0.7 typ	0.3 typ	4	1	180
		<b>2N6578<sup>(2)</sup></b>		2k/20k	4	2	7	10	10-200 <sup>(1)</sup>	120
	140	MJ15001	MJ15002	25/150	4				2	200
	150	MJ11018 <sup>(2)</sup>	MJ11017 <sup>(2)</sup>	100 min	15				3 <sup>(1)</sup>	175
	200	MJ11020 <sup>(2)</sup>		100 min	15				3 <sup>(1)</sup>	175
		<b>MJ3281A</b>	<b>MJ1302A</b>	60/175	0.1				30 typ	250
	250	<b>MJ11022<sup>(2)</sup></b>	MJ11019 <sup>(2)</sup>	100 min	15				3 <sup>(1)</sup>	175
			<b>MJ11021<sup>(2)</sup></b>	6/30	10	4	0.7	10	6 to 24	175
	400/850	<b>BUX48</b>		8 min	10	2	0.4	10		175
		2N6547		6/30	10	4	0.7	10	6 to 24	175
400/650	<b>MJ16110</b>		6/20	15	0.8 typ	0.1 typ	10		175	
450/1000	<b>BUX48A</b>		8 min	8	2	0.4	10		175	

<sup>(1)</sup>h<sub>FEI</sub> @ 1 MHz

<sup>(2)</sup>Darlington

<sup>(8)</sup>When 2 voltages are given, the format is V<sub>CEO(sus)</sub>/V<sub>CEs</sub>.

Devices listed in bold, italic are Motorola preferred devices.

Table 7. Metal TO-204AA (Formerly TO-3), TO-204AE (continued)

I <sub>C</sub> Cont Amps Max	V <sub>CEO(sus)</sub> Volts Min <sup>(8)</sup>	Device Type		h <sub>FE</sub> Min/Max	@ I <sub>C</sub> Amp	Resistive Switching			f <sub>T</sub> MHz Min	P <sub>D</sub> (Case) Watts @ 25°C
		NPN	PNP			t <sub>s</sub> μs Max	t <sub>f</sub> μs Max	@ I <sub>C</sub> Amp		
15	450/850	MJ16010		5 min	15	1.2 typ	0.2 typ	10		175
		<b>MJ16012</b>		7 min	15	0.9 typ	0.15 typ	10		175
16	140	<b>2N3773</b>	2N6609	15/60	8	1.1 typ	1.5 typ	8	4	150
		2N5631	2N6031	15/60	8	1.2 typ	1.2 typ	8	1	200
	200	MJ15022	MJ15023	15/60	8				5	250
	250	<b>MJ15024</b>	<b>MJ15025</b>	15/60	8				5	250
		<b>MJ21194</b>	<b>MJ21193</b>	25/75	8				4	250
20	60	<b>2N3772</b>		15/60	10				2	150
		2N6282 <sup>(2)</sup>	2N6285 <sup>(2)</sup>	750/18k	10	2.5 typ	2.5 typ	10	4 <sup>(1)</sup>	160
	75	2N5039		20/100	10	1.5	0.5	10	60	140
	80	<b>2N6283</b> <sup>(2)</sup>	2N6286 <sup>(2)</sup>	750/18k	10	2.5 typ	2.5 typ	10	4 <sup>(1)</sup>	160
	90	2N5038		20/100	12	1.5	0.5	12	60	140
	100	<b>2N6284</b> <sup>(2)</sup>	<b>2N6287</b> <sup>(2)</sup>	750/18k	10	2.5 typ	2.5 typ	10	4 <sup>(1)</sup>	160
	140	<b>MJ15003</b>	<b>MJ15004</b>	25/150	5				2	250
	200	<b>BUV11</b>		10 min	12	1.8	0.4	12	8	150
	350	<b>MJ10000</b> <sup>(2)</sup>		40/400	10	3	1.8	10	10 <sup>(1)</sup>	175
	400	<b>MJ10005</b> <sup>(2)</sup>		40/400	10	1.5	0.5	10	10 <sup>(1)</sup>	175
		<b>MJ13333</b>		10/60	5	4	0.7	10		175
	500	<b>MJ10009</b> <sup>(2)</sup>		30/300	10	2	0.6	10	8 <sup>(1)</sup>	175
25	60	2N5885	2N5883	20/100	10	1	0.8	10	4	200
		<b>2N5886</b>	<b>2N5884</b>	20/100	10	1	0.8	10	4	200
			2N6436	30/120	10	1	0.25	10	40	200
	100	2N6338	2N6437	30/120	10	1	0.25	10	40	200
	120	2N6339	<b>2N6438</b>	30/120	10	1	0.25	10	40	200
	140	2N6340		30/120	10	1	0.25	10	40	200
	150	<b>2N6341</b>		30/120	10	1	0.25	10	40	200
30	40	<b>2N3771</b>		15/60	15				2	150
		2N5301	2N4398	15/60	15	2	1	10	2	200
	60	2N5302	2N4399	15/60	15	2	1	10	2	200
		MJ11012 <sup>(2)</sup>	MJ11011 <sup>(2)</sup>	1k min	20				4 <sup>(1)</sup>	200
	90	<b>MJ11014</b> <sup>(2)</sup>	<b>MJ11013</b> <sup>(2)</sup>	1k min	20				4 <sup>(1)</sup>	200
	100	2N6328		6/30	30				3	200
		<b>MJ802</b>	<b>MJ4502</b>	25/100	7.5				2	200
	120	<b>MJ11016</b> <sup>(2)</sup>	<b>MJ11015</b> <sup>(2)</sup>	1k min	20				4 <sup>(1)</sup>	200

<sup>(1)</sup>h<sub>FE</sub> @ 1 MHz

<sup>(2)</sup>Darlington

<sup>(8)</sup>When 2 voltages are given, the format is V<sub>CEO(sus)</sub>/V<sub>CE(s)</sub>.

Devices listed in bold, italic are Motorola preferred devices.

Table 7. Metal TO-204AA (Formerly TO-3), TO-204AE (continued)

I <sub>C</sub> Cont Amps Max	V <sub>CEO(sus)</sub> Volts Min <sup>(8)</sup>	Device Type		h <sub>FE</sub> Min/Max	@ I <sub>C</sub> Amp	Resistive Switching			f <sub>T</sub> MHz Min	PD (Case) Watts @ 25°C	
		NPN	PNP			t <sub>s</sub> μs Max	t <sub>f</sub> μs Max	@ I <sub>C</sub> Amp			
30	325	<b>BUV23</b>		8 min	16	1.8	0.4	16	8	250	
	400/1000	<b>BUS98</b>		8 min	20	2.3	0.4	20		250	
		<b>BUX98</b>		8 min	20	3	0.8	20		250	
	450/850	MJ16020 <sup>(16)</sup>		5 min	30	1.8	0.2	20		250	
		<b>MJ16022</b> <sup>(16)</sup>		7 min	30	1.5	0.15	20		250	
	450/1000	<b>BUS98A</b>		8 min	16	2.3	0.4	16		250	
<b>BUX98A</b>			8 min	16	3	0.8	16		250		
40	200	BUV21 <sup>(16)</sup>		10 min	25	1.8	0.4	25	8	150	
	250	<b>BUV22</b> <sup>(16)</sup>		10 min	20	1.1	0.35	20	8	250	
	350	MJ10022 <sup>(2)(16)</sup>		50/600	10	2.5	0.9	20		250	
	400	<b>MJ10023</b> <sup>(2)(16)</sup>		50/600	10	2.5	0.9	20		250	
50	60	2N5685 <sup>(16)</sup>		15/60	25	0.5 typ	0.3 typ	25	2	300	
	80	<b>2N5686</b> <sup>(16)</sup>	<b>2N5684</b> <sup>(16)</sup>	15/60	25	0.5 typ	0.3 typ	25	2	300	
	90	<b>MJ11030</b> <sup>(2)(16)</sup>	<b>MJ11031</b> <sup>(2)(16)</sup>	400 min	50					300	
	100	2N6274 <sup>(16)</sup>		30/120	20	0.8	0.25	20	30	250	
	120	2N6275 <sup>(16)</sup>	<b>2N6379</b> <sup>(16)</sup>		30/120	20	0.8	0.25	20	30	250
		<b>MJ11032</b> <sup>(2)(16)</sup>	<b>MJ11033</b> <sup>(2)(16)</sup>	400 min	50					300	
	125	<b>BUV20</b> <sup>(16)</sup>			10 min	50	1.2	0.25	50	8	250
		<b>BUV60</b> <sup>(16)</sup>			10 min	80	1.1	0.25	80		250
	150	<b>2N6277</b> <sup>(16)</sup>			30/120	20	0.8	0.25	20	30	250
	400	<b>MJ10015</b> <sup>(2)(16)</sup>			10 min	40	2.5	1	20		250
	500	<b>BUT34</b> <sup>(2)(16)</sup>			15 min	32	3	1.5	32		250
		<b>MJ10016</b> <sup>(2)(16)</sup>			10 min	40	2.5	1	20		250
56	400	<b>BUT33</b> <sup>(2)(16)</sup>		20 min	36	3.3	1.6	36		250	
60	60		MJ14001 <sup>(16)</sup>	15/100	50					300	
	80	<b>MJ14002</b> <sup>(16)</sup>	<b>MJ14003</b> <sup>(16)</sup>	15/100	50					300	
	200	MJ10020 <sup>(2)(16)</sup>		75 min	15	3.5	0.5	30		250	
	250	<b>MJ10021</b> <sup>(2)(16)</sup>		75 min	15	3.5	0.5	30		250	
70	125	<b>BUS50</b> <sup>(16)</sup>		15 min	50	1.5	0.3	70		350	
80	100	<b>BUV18A</b> <sup>(16)</sup>		10 min	80	1.1	0.25	80		250	

(1)h<sub>FE</sub> @ 1 MHz

(2)Darlington

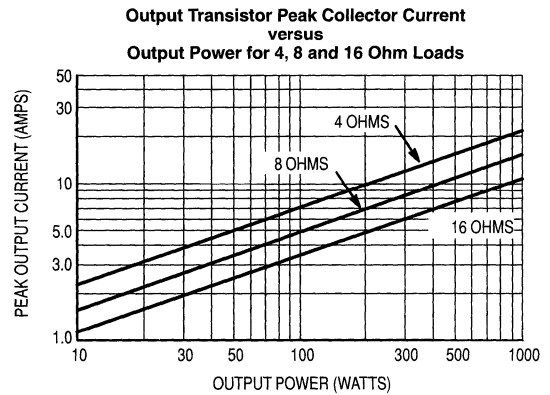
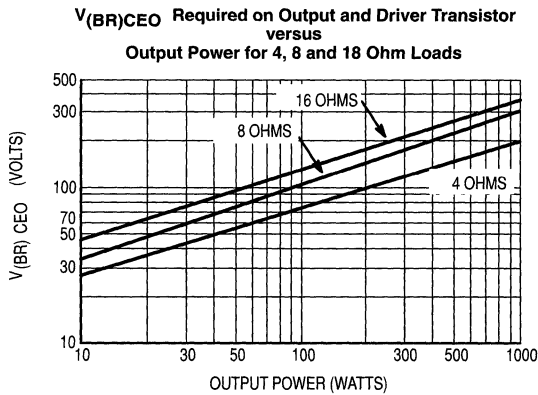
(8)When 2 voltages are given, the format is V<sub>CEO(sus)</sub>/V<sub>CES</sub>

(16)Case 197A-03 (TO-204AE)

Devices listed in bold, italic are Motorola preferred devices.

# Audio

## GENERAL DESIGN CURVES FOR POWER AUDIO OUTPUT STAGES



Another important parameter that must be considered before selecting the output transistors is the safe-operating area these devices must withstand. For a complete discussion see Application Note AN485.

**Table 8. Recommended Power Transistors for Audio/Servo Loads**

RMS Power Output	NPN	PNP	Case	PD Watts @ 25°C	$V_{CEO}$	$h_{FE}$ @ Min/Max	$I_C$ Amps	$f_T$ MHz Typ	ISB Volts/Amps
To 25W	MJE15030	MJE15031	TO-220	50	150	20 min	4	30	14/3.6
	MJE15032	MJE15033	TO-220	50	250	50 min	1	40	50/1
25 to 50W	2N3055A	MJ2955A	TO-204	120	120	20/70	4	3	60/2
	MJ15001	MJ15002	TO-204	200	140	25/150	4	3	40/5
50 to 100W	MJ15015	MJ15016	TO-204	180	120	20/70	4	3	60/3
	MJ15003	MJ15004	TO-204	250	140	25/150	5	3	100/1
	MJ15020	MJ15021	TO-204	150	250	30 min	1	20	50/3
Over 100W	MJ15024	MJ15025	TO-204	250	250	15/60	8	8	80/2.2
	MJ3281A	MJ1302A	TO-204	250	200	60/175	7	30	50/4
	MJL3281A	MJL1302A	340G-01	150	200	60/175	7	30	40/4
	MJ21194	MJ21193	TO-204	250	250	25/75	8	7	100/2
	MJL21194	MJL21193	340G-01	200	200	25/75	8	7	100/2

The Power Transistors shown are provided for reference only and show device capability. The final choice of the Power Transistors used is left to the circuit designer and depends upon the particular safe-operating area required and the mounting and heat sinking configuration used.

# Electronic Lamp Ballasts

As in many other areas of its semiconductor activity, Motorola is an industry leader in the fast growing market of Electronic Ballast Semiconductors. We introduced the first dedicated devices for this market in 1988. Today, devices based on advanced technologies such as H2BIP (High Gain, High Frequency Bipolar) and ZPCMOS (Zero Power Control MOS) are leading the way in providing benefits for ballast manufacturers, consumers and the environment.

Two factors make the Electronic Lamp Ballast market grow at an ever increasing rate — Economics and the Environment.

Lamps based on Electronic Ballasts have long lifetimes and very low power consumption, so contributing to the efficient use of energy and to preservation of the environment. Motorola designs silicon solutions specifically for these applications.

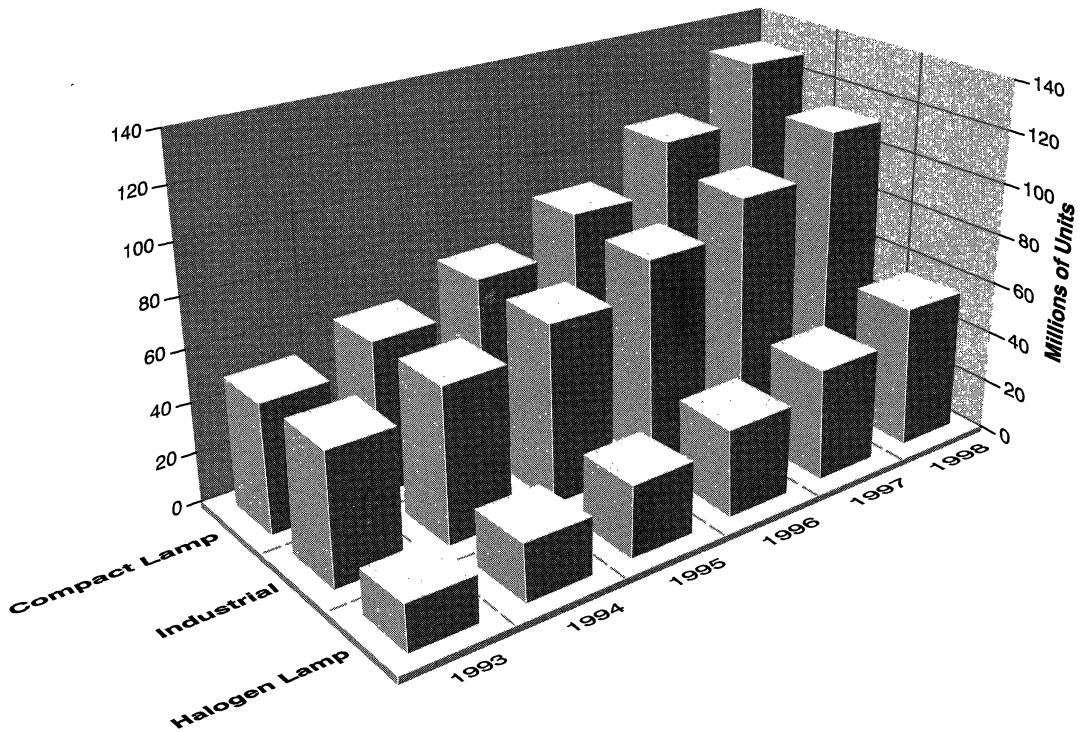
For this growing ballast market Motorola offers optimized devices such as Power MOSFETs, Bipolar Transistors, Linear drive ICs, custom Start–Stop ICs, Diodes and Silicon Bilateral Switches.

Even more important are our efforts to develop the technology for tomorrow in close cooperation with the world's leading manufacturers of Electronic Transformers and Lamp Ballasts, as well as assisting them today in their choice of technology.

This capability is driven from our centre of competence based in Toulouse, France. An important team of Applications, Design, Product, Manufacturing and Marketing Engineers drives our worldwide dedication to this market.

The intention of this section is to provide you with a 'snapshot' of our bipolar transistor products and capabilities. It is a document showing Motorola's professionalism in this area, and illustrating some of the expertise available to you — the Electronic Lamp Ballast manufacturer.

### World Lamp Ballast Market



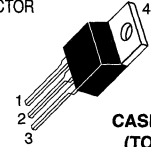
# Cross Reference Transistors for Electronic Lamp Ballasts

Industry Part Number	Motorola Direct Replacement	Motorola Nearest Replacement
2SC4053		MJE18004
2SC4546		BUL146F
2SC4630		MJF18004
2SC4820		MJF18002
BU1706A		MJE18604D2
BU1708A		MJE18604D2
BUD43B-1	BUD43B-1	
BUF610		MJE18004D2
BUF654		BUL146
BUH100	BUH100	
BUH150	BUH150	
BUH50	BUH50	
BUH51	BUH51	
BUL146	BUL146	
BUL146F	BUL146F	
BUL147	BUL147	
BUL147F	BUL147F	
BUL213		MJE18204
BUL216		MJE18206
BUL381		BUL45
BUL38D		BUL45D2
BUL410		MJE18006
BUL416		MJE18604D2
BUL43B	BUL43B	
BUL44	BUL44	
BUL44D2	BUL44D2	
BUL44F	BUL44F	
BUL45	BUL45	
BUL45D2	BUL45D2	
BUL45F	BUL45F	
BUL48		MJE18004D2
BUL510		MJE18004D2
BUL57		BUL147
BUL67		BUL147
BUL810		BUV48A
BUL87		BUL147
BULD215		BUL45D2

Industry Part Number	Motorola Direct Replacement	Motorola Nearest Replacement
BULD50		BUL44D2
BULD85		BUL45D2
BUT11AF		MJF18004
BUT18		BUH100
BUT93		BUL45
BUT93D		BUL44D2
BUV46		MJE18006
KSC5021F		MJE18004
KSC5027F		MJE18604D2
MJD13003-1	MJE13003-1	
MJE13003	MJE13003	
MJE13005	MJE13005	
MJE13007	MJE13007	
MJE13009	MJE13009	
MJE18002	MJE18002	
MJE18004	MJE18004	
MJE18004D2	MJE18004D2	
MJE18006	MJE18006	
MJE18008	MJE18008	
MJE18009	MJE18009	
MJE18204	MJE18204	
MJE18206	MJE18206	
MJE18604D2	MJE18604D2	
MJF18002	MJF18002	
MJF18004	MJF18004	
MJF18006	MJF18006	
MJF18008	MJF18008	
MJF18009	MJF18009	
MJF18204	MJF18204	
MJF18206	MJF18206	
TD13003		MJD13003-1
TD13004		BUF43B-1
TEO13005D		BUL44D2-1
TEO13007	MJE13007	
TEO13003	MJE13003	
TEO13005	MJE13005	
TEO13009	MJE13009	

# Cross Reference Transistors for Electronic Lamp Ballasts

- STYLE 1:  
 PIN 1. BASE  
 2. COLLECTOR  
 3. EMITTER  
 4. COLLECTOR



**CASE 221A-06  
(TO-220AB)**

**Table 9. TO-220AB Bipolar Transistors**

I <sub>C</sub> Cont Amps Max	V <sub>CEO</sub> (sus) Volts Min	V <sub>CES</sub> Volts Min	Device Type	I <sub>C</sub> Operating Amps	h <sub>FE</sub> min @ I <sub>C</sub> Operating V <sub>CE</sub> = 1 V	Inductive Switching @ I <sub>C</sub> Operating T <sub>si</sub> Min/Max (μs)	P <sub>D</sub> (Case) Watts @ 25°C
2	350	650	BUL43B	0.8	9	1.8 / 3.3	40
	400	700	BUL44	0.8	10	2.6 / 3.8	50
	400	700	BUL44D2*	0.8	20	2.05 / 2.35	50
	450	1000	MJE18002	1	6	/ 2.75	50
4	500	800	BUH50	2	8 typ	/ 2.5	50
5	400	700	BUL45	2	7	2.6 / 3.8	75
	400	700	BUL45D2*	2	10	1.95 / 2.25	75
	450	1000	MJE18004	2	6	/ 2.5	75
	450	1000	MJE18004D2*	2	6	2.1 / 2.4	75
	550	1200	MJE18204	2	5	/ 2.75	75
	600	1600	MJE18604D2*	0.5	15	/ 1.0	75
6	400	700	BUL146	3	8	2.6 / 3.8	100
	450	1000	MJE18006	3	6	/ 3.2	100
8	400	700	BUL147	4.5	8	2.6 / 3.8	125
	450	1000	MJE18008	4.5	6	/ 3.2	125
	550	1200	MJE18206	3	5	/ 2.75	100
10	400	700	BUH100	5	10 typ	/ 3.0	100
	450	1000	MJE18009	7	8	/ 2.75	150
15	400	700	BUH150	10	8 typ	/ 2.75	150

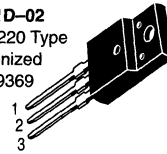
BUHXXX Series are specified for Halogen applications.

\* D2 suffix indicates transistor with built in C-E freewheeling diode and antisaturation network.



# Cross Reference Transistors for Electronic Lamp Ballasts

CASE 221D-02  
Isolated TO-220 Type  
UL Recognized  
File #E69369

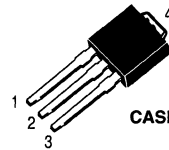


STYLE 1:  
PIN 1. BASE  
2. COLLECTOR  
3. EMITTER

Table 10. Isolated TO-220 Bipolar Transistors

I <sub>C</sub> Cont Amps Max	V <sub>CEO(sus)</sub> Volts Min	V <sub>CES</sub> Volts Min	Device Type	I <sub>C</sub> Operating Amps	h <sub>FE</sub> min @ I <sub>C</sub> Operating V <sub>CE</sub> = 1 V	Inductive Switching @ I <sub>C</sub> Operating T <sub>SI</sub> Min/Max (μs)	P <sub>D</sub> (Case) Watts @ 25°C
2	400	700	BUL44F	0.8	10	2.6 / 3.8	25
	450	1000	MJF18002	1	6	/ 2.75	25
5	400	700	BUL45F	2	7	2.6 / 3.8	35
	450	1000	MJF18004	2	6	/ 2.5	35
	550	1200	MJF18204	2	5	/ 2.75	40
6	400	700	BUL146F	3	8	2.6 / 3.8	40
	450	1000	MJF18006	3	6	/ 3.2	40
8	400	700	BUL147F	4.5	8	2.6 / 3.8	45
	450	1000	MJF18008	4.5	6	/ 3.2	45
	550	1200	MJF18206	5	6	/ 2.75	45
10	450	1000	MJF18009	7	8	/ 2.75	50

STYLE 1:  
PIN 1. BASE  
2. COLLECTOR  
3. EMITTER  
4. COLLECTOR



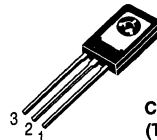
CASE 369-07

Table 11. DPAK Bipolar Transistors

I <sub>C</sub> Cont Amps Max	V <sub>CEO(sus)</sub> Volts Min	V <sub>CES</sub> Volts Min	Device Type	I <sub>C</sub> Operating Amps	h <sub>FE</sub> min @ I <sub>C</sub> Operating V <sub>CE</sub> = 1 V	Inductive Switching @ I <sub>C</sub> Operating T <sub>SI</sub> Min/Max (μs)	P <sub>D</sub> (Case) Watts @ 25°C
2	350	650	BUD43B-1	0.8	9 typ	1.8 / 3.3	25
	400	700	BUD44D2-1*	0.8	20 typ	2.05 / 2.35	25

STYLE 1:  
PIN 1. EMITTER  
2. COLLECTOR  
3. BASE

STYLE 3:  
PIN 1. BASE  
2. COLLECTOR  
3. EMITTER



CASE 77-08  
(TO-225AA)

Table 12. Case 77 (TO-225) Bipolar Transistors

I <sub>C</sub> Cont Amps Max	V <sub>CEO(sus)</sub> Volts Min	V <sub>CES</sub> Volts Min	Device Type	I <sub>C</sub> Operating Amps	h <sub>FE</sub> min @ I <sub>C</sub> Operating V <sub>CE</sub> = 1 V	Inductive Switching @ I <sub>C</sub> Operating T <sub>SI</sub> Min/Max (μs)	P <sub>D</sub> (Case) Watts @ 25°C
1.5	400	700	MJE13003	1	6 typ	/ 3.0	40
4	400	700	BUH51	1	8	/ 3.75	50

BUHXXX Series are specified for Halogen applications.

\* D2 suffix indicates transistor with built in C-E freewheeling diode and antisaturation network.



# Rectifiers

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## In Brief . . .

Continuing investment in research and development for discrete products has created a rectifier manufacturing facility that matches the precision and versatility of the most advanced integrated circuits. As a result, Motorola's silicon rectifiers span all high tech applications with quality levels capable of passing the most stringent environmental tests . . . including those for automotive under-hood applications. Additionally, the introduction of Motorola's first generation GaAs power devices is pushing the limits of today's rectifier technology.

### Product Highlights:

- GaAs Rectifiers Power Manager™ with incredibly soft and hyperfast (<15 ns) reverse recovery are ideally suited for high frequency power supplies, free wheeling diodes, and as polarity protection diodes.
- Surface Mount Devices — A major thrust has been the development and introduction of a broad range of power rectifiers. Schottky and Ultrafast, 1/2 amp to 25 amp, 15 to 600 volts.
- Application Specific Rectifiers —
  - MEGAHERTZ™ series for high frequency power supplies and power factor correction.
  - Schottky rectifiers having lower forward voltage drop (0.3 to 0.6 volts) for use in low voltage SMPS outputs and as "OR"ing diodes.
  - Automotive transient suppressors.
- Ultrafast rectifiers having reverse recovery times as low as 25 ns to complement the Schottky devices for higher voltage requirements in high frequency applications.
- A wide variety of package options to match virtually any potential requirement.

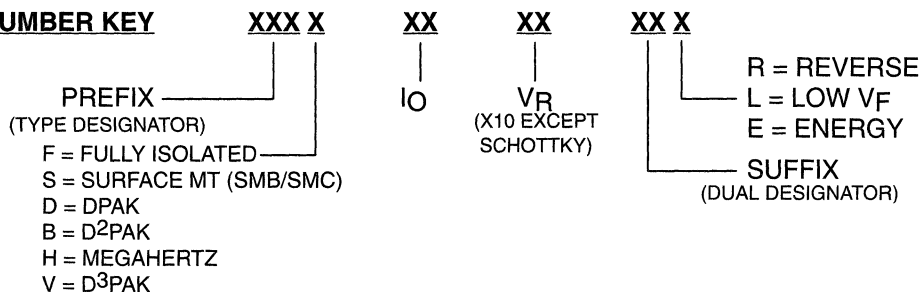
The rectifier selector section that follows has generally been arranged by package and technology. The individual tables have been sorted by voltage and current with the package types for the devices listed shown above each table. The Application Specific Rectifiers are also included in their respective tables.

Motorola's commitment to Six-Sigma is showing its worth. Refined processes no longer produce fallout as such and therefore only **Motorola Preferred Devices** are listed in the tables. The non-preferred devices will continue to be offered, but customers are encouraged to begin designing using the preferred types.

	<b>Page</b>
Rectifier Numbering System . . . . .	5.6-2
Application Specific Rectifiers . . . . .	5.6-3
Low V <sub>F</sub> Schottky . . . . .	5.6-3
MEGAHERTZ . . . . .	5.6-3
SCANSWITCH . . . . .	5.6-3
Automotive Transient Suppressors . . . . .	5.6-3
SWITCHMODE™ Rectifiers . . . . .	5.6-4
Surface Mount Schottky . . . . .	5.6-4
Axial Lead Schottky . . . . .	5.6-6
TO-220 Type Schottky . . . . .	5.6-7
TO-218 Types and TO-247 Schottky . . . . .	5.6-8
POWERTAP II . . . . .	5.6-9
Ultrafast Rectifiers . . . . .	5.6-10
Surface Mount Ultrafast . . . . .	5.6-10
Axial Lead Ultrafast . . . . .	5.6-10
TO-220 Type Ultrafast . . . . .	5.6-11
TO-218 Types and TO-247 Ultrafast . . . . .	5.6-12
POWERTAP II . . . . .	5.6-12
Fast Recovery Rectifiers/General Purpose Rectifiers . . . . .	5.6-13
GaAs Rectifiers Power Manager™ . . . . .	5.6-14

# RECTIFIER NUMBERING SYSTEM

## PART NUMBER KEY



## PREFIX KEY

MUR = MOTOROLA ULTRA FAST RECTIFIER  
 MBR = MOTOROLA (SCHOTTKY) BARRIER RECTIFIER  
 MGR = MOTOROLA GaAs RECTIFIER  
 MR = MOTOROLA STANDARD & FAST RECOVERY

## SUFFIX KEY

CT = CENTER TAP (DUAL) TO-220, TO-3, POWERTAP II  
 PT = CENTER TAP (DUAL) TO-218 PACKAGE  
 WT = CENTER TAP (DUAL) TO-247 / TO-3P

<b>EXAMPLE:</b>	MUR	30	20	WT
	MOTOROLA ULTRAFAST	30 AMP	200 V	CENTER TAP (DUAL) TO-247
<b>EXAMPLE:</b>	MBR	30	45	WT
	MOTOROLA SCHOTTKY	30 AMP	45 V	CENTER TAP (DUAL) TO-247

# Application Specific Rectifiers

The focus for Rectifier Products continues to be on Schottky and Ultrafast technologies, with process and packaging improvements to achieve greater efficiency in high frequency switching power supplies, and high current

mainframe supplies. Our new product thrust is intended to be more "application specific" than in the past, while continuing to strive for broad market acceptance.

**Table 1. Low  $V_F$  Schottky Rectifiers**

State of the art geometry is used in low  $V_F$  Schottky devices for improved efficiency in low voltage, high frequency switching power supplies, free-wheeling diodes, polarity protection diodes and "OR"ing diodes.

Device	$I_O$ Amps	$V_{RRM}$ (Volts)	$V_F$ @ Rated $I_O$ and Temperature Volts (Max)	$I_R$ @ Rated $V_{RRM}$ mAmps (Max)	Package
<i>MBR0520LT1</i>	0.5	20	0.33	0.25	SOD-123
<i>MBRS130LT3</i>	1	30	0.395	1	SMB
<i>MBRD835L</i>	8	35	0.41	1.4	DPAK
<i>MBRD1035CTL</i>	10	35	0.41	6	DPAK
<i>MBR2030CTL</i>	20	30	0.48	5	TO-220
<i>MBRB2535CTL</i>	25	35	0.41	10	D <sup>2</sup> PAK
<i>MBR2535CTL</i>	25	35	0.41	5	TO-220
<i>MBRB2515L</i>	25	15	0.42	15	D <sup>2</sup> PAK
<i>MBR2515L</i>	25	15	0.42	15	TO-220
<i>MBRB3030CTL</i>	30	30	0.58	5	D <sup>2</sup> PAK
<i>MBR4015LWT</i>	40	15	0.42	5	TO-247
<i>MBR5025L</i>	50	25	0.58	0.5	TO-218
<i>MBRP20030CTL</i>	200	30	0.39	5	POWERTAP II
<i>MBRP60035CTL</i>	600	35	0.50	10	POWERTAP II

**Table 2. MEGAHERTZ Rectifiers**

MEGAHERTZ Series — This group of ultrafast rectifiers is designed to provide improved efficiency in very high frequency switching power supplies and for use in power factor correction circuits.

Device	$I_O$ Amps	$V_{RRM}$ (Volts)	Maximum		$t_{rr}$ (Nanosecond)
			$V_F$ @ Rated $I_O$ and Temp. (Volts)	$I_R$ @ Rated $V_{RRM}$ (mAmps)	
<i>MURH840CT/MURHB840CT</i>	8	400	1.7	0.01	28
<i>MURH860CT</i>	8	600	2.0	0.01	28

**Table 3. SCANSWITCH Rectifiers**

These ultrafast rectifiers are designed for improved performance in very high resolution monitors and work stations where forward recovery time ( $t_{fr}$ ) and high voltage (1200–1500 volts) are primary considerations.

Device	$I_O$ Amps	$V_{RRM}$ (Volts)	Maximum		$V_{RFM}^{(6)}$ (Volts)
			$t_{fr}$ (Nanoseconds)	$t_{rr}$ (Nanoseconds)	
<i>MUR880E</i>	8	800	—	75	—
<i>MUR10120E</i>	10	1200	175	175	14
<i>MUR10150E</i>	10	1500	175	175	16

**Table 4. Automotive Transient Suppressors**

Automotive transient suppressors are designed for protection against over-voltage conditions in the auto electrical system including the "LOAD DUMP" phenomenon that occurs when the battery open circuits while the car is running.

Device	$I_O$ Amps	$V_{RRM}$ (Volts)	$V_{(BR)}$ (Volts)	$I_{RSM}^{(7)}$ (Amps)	T (°C)
<i>MR2535L/MR2535S</i>	35	20	24–32	110	175

<sup>(6)</sup> $V_{RFM}$  = Maximum Transient Overshoot Voltage.

<sup>(7)</sup>Time constant = 10 ms, Duty Cycle ≤ 1%,  $T_C$  = 25°C.

Devices listed in bold, italic are Motorola preferred devices.

# SWITCHMODE™ Rectifiers

Schottky power rectifiers with the high speed and low forward voltage drop characteristic of Schottky's metal/silicon junctions are produced with ruggedness and temperature performance comparable to silicon-junction rectifiers. Ideal for use in low-voltage, high-frequency power supplies, and as very fast clamping diodes, these devices feature switching times less than 10 ns, and are offered in current ranges from 0.5 to 600 amperes, and reverse voltages to 200 volts.

In some current ranges, devices are available with junction temperature specifications of 125°C, 150°C and 175°C. Devices with higher T<sub>J</sub> ratings can have significantly lower leakage currents, but higher forward-voltage specifications. These parameter tradeoffs should be considered when selecting devices for applications that can be satisfied by more than one device type number.

All devices are connected cathode-to-case or cathode-to-heatsink, where applicable. Contact your Motorola representative for more information.

There are many other standard features in Motorola Schottky rectifiers that give added performance and reliability.

1. GUARDRINGS were pioneered by Motorola and are included in all Schottky die for reverse voltage stress protection from high rates of dv/dt to virtually eliminate the need for snubber networks. The guarding also operates like a zener and avalanches when subjected to voltage transients.

2. MOLYBDENUM DISCS on both sides of the die minimize fatigue from power cycling in all metal products. Plastic encapsulated devices have a special solder formulation for the same purpose.

3. QUALITY CONTROL monitors all critical fabrication operations and performs selected stress tests to assure constant processes. Motorola's commitment to six sigma has provided significant quality improvement.

Case 425  
SOD-123



Cathode = Band

Case 403B-01  
SMA



Cathode = Notch

Case 403A  
SMB



Cathode = Notch

Case 403  
SMC



Cathode = Notch

Table 5. Surface Mount Schottky Rectifiers

V <sub>RRM</sub> (Volts)	I <sub>O</sub> <sup>(1)</sup> (Amperes)	I <sub>O</sub> Rating Condition	Device	Max V <sub>F</sub> @ I <sub>F</sub> T <sub>C</sub> = 25°C (Volts)	I <sub>FSM</sub> (Amperes)	T <sub>J</sub> Max (°C)	Package
20	0.5	T <sub>L</sub> = 105°C	<b><i>MBR0520LT1</i></b> ★	0.310 @ 0.1 A 0.385 @ 0.5 A	5	125	SOD-123
30	0.5	T <sub>L</sub> = 105°C	<b><i>MBR0530T1</i></b> ★	0.375 @ 0.1 A 0.430 @ 0.5 A	5	125	SOD-123
40	0.5	T <sub>L</sub> = 110°C	<b><i>MBR0540T1</i></b> ★	0.53 @ 0.5 A	20	150	SOD-123
30	1	T <sub>L</sub> = 100°C	<b><i>MBRA130LT3</i></b> ★	0.395 @ 1.0 A	—	125	SMA
40	1	T <sub>L</sub> = 100°C	<b><i>MBRA140T3</i></b> ★	0.55 @ 1.0 A	—	125	SMA
30	1	T <sub>L</sub> = 120°C	<b><i>MBRS130LT3</i></b>	0.395 @ 1.0 A	40	125	SMB
40	1	T <sub>L</sub> = 115°C	<b><i>MBRS140T3</i></b>	0.6 @ 1.0 A	40	125	SMB
100	1	T <sub>L</sub> = 120°C	<b><i>MBRS1100T3</i></b>	0.75 @ 1.0 A	40	150	SMB
40	3	T <sub>L</sub> = 100°C	<b><i>MBRS340T3</i></b>	0.525 @ 3.0 A	80	125	SMC
60	3	T <sub>L</sub> = 100°C	<b><i>MBRS360T3</i></b> ★	0.74 @ 3.0 A	80	125	SMC

(1) I<sub>O</sub> is total device current capability.

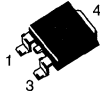
★ New Product

Devices listed in bold, italic are Motorola preferred devices.

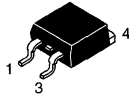
Case 433-01  
D<sup>3</sup>PAK



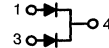
Case 369A  
DPAK  
Style 3



Case 418B  
D<sup>2</sup>PAK  
Style 3



"CT" Suffix:



Non-"CT" Suffix:

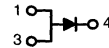


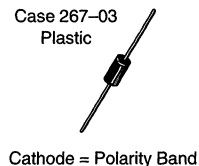
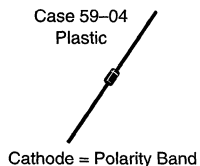
Table 5. Surface Mount Schottky Rectifiers (continued)

V <sub>RRM</sub> (Volts)	I <sub>O</sub> (1) (Amperes)	I <sub>O</sub> Rating Condition	Device	Max V <sub>F</sub> @ I <sub>F</sub> T <sub>C</sub> = 25°C (Volts)	I <sub>FSM</sub> (Amperes)	T <sub>J</sub> Max (°C)	Package
40	3	T <sub>C</sub> = 125°C	<b><i>MBRD340</i></b>	0.60 @ 3.0 A	75	150	DPAK
60	3	T <sub>C</sub> = 125°C	<b><i>MBRD360</i></b>	0.60 @ 3.0 A	75	150	DPAK
40	6	T <sub>C</sub> = 130°C	<b><i>MBRD640CT</i></b>	0.70 @ 3.0 A	75	150	DPAK
60	6	T <sub>C</sub> = 130°C	<b><i>MBRD660CT</i></b>	0.70 @ 3.0 A	75	150	DPAK
35	8	T <sub>C</sub> = 100°C	<b><i>MBRD835L</i></b> ★	0.40 @ 3.0 A 0.51 @ 8.0 A	100	125	DPAK
35	10	T <sub>C</sub> = 90°C	<b><i>MBRD1035CTL</i></b> ★	0.49 @ 10 A	100	125	DPAK
45	15	T <sub>C</sub> = 105°C	<b><i>MBRB1545CT</i></b>	0.84 @ 15 A	150	150	D <sup>2</sup> PAK
60	20	T <sub>C</sub> = 110°C	<b><i>MBRB2060CT</i></b>	0.95 @ 20 A	150	150	D <sup>2</sup> PAK
100	20	T <sub>C</sub> = 110°C	<b><i>MBRB20100CT</i></b>	0.85 @ 10 A 0.95 @ 20 A	150	150	D <sup>2</sup> PAK
200	20	T <sub>C</sub> = 125°C	<b><i>MBRB20200CT</i></b> ★	1.0 @ 20 A	150	150	D <sup>2</sup> PAK
15	25	T <sub>C</sub> = 90°C	<b><i>MBRB2515L</i></b> ★	0.45 @ 25 A	150	100	D <sup>2</sup> PAK
35	25	T <sub>C</sub> = 110°C	<b><i>MBRB2535CTL</i></b>	0.47 @ 12.5 A 0.55 @ 25 A	150	125	D <sup>2</sup> PAK
45	25	T <sub>C</sub> = 130°C	<b><i>MBRB2545CT</i></b>	0.82 @ 30 A	150	150	D <sup>2</sup> PAK
30	30	T <sub>C</sub> = 115°C	<b><i>MBRB3030CT</i></b> ★	0.51 @ 15 A 0.62 @ 30 A	300	150	D <sup>2</sup> PAK
30	30	T <sub>C</sub> = 95°C	<b><i>MBRB3030CTL</i></b> ★	0.45 @ 15 A 0.51 @ 30 A	150	125	D <sup>2</sup> PAK
30	40	T <sub>C</sub> = 110°C	<b><i>MBRB4030</i></b> ★	0.46 @ 20 A 0.55 @ 40 A	300	150	D <sup>2</sup> PAK
30	70	T <sub>C</sub> = 90°C	<b><i>MBRV7030CTL</i></b> ★	0.5 @ 35 A 0.62 @ 70 A	500	150	D <sup>3</sup> PAK

(1) I<sub>O</sub> is total device current capability.

★ New Product

Devices listed in bold, italic are Motorola preferred devices.



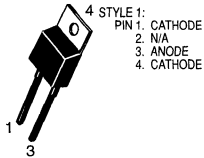
**Table 6. Axial Lead Schottky Rectifiers**

$V_{RRM}$ (Volts)	$I_O$ (Amperes)	$I_O$ Rating Condition	Device	Max $V_F$ @ $I_F$ $T_C = 25^\circ\text{C}$ (Volts)	$I_{FSM}$ (Amperes)	$T_J$ Max ( $^\circ\text{C}$ )	Case
20	1	$T_A = 55^\circ\text{C}$ $R_{\theta JA} = 80^\circ\text{C/W}$	<b>1N5817</b>	0.45 @ 1.0 A	25	125	59-04
30	1	$T_A = 55^\circ\text{C}$ $R_{\theta JA} = 80^\circ\text{C/W}$	<b>1N5818</b>	0.55 @ 1.0 A	25	125	59-04
40	1	$T_A = 55^\circ\text{C}$ $R_{\theta JA} = 80^\circ\text{C/W}$	<b>1N5819</b>	0.60 @ 1.0 A	25	125	59-04
60	1	$T_A = 55^\circ\text{C}$ $R_{\theta JA} = 80^\circ\text{C/W}$	<b>MBR160</b>	0.75 @ 1.0 A	25	150	59-04
100	1	$T_A = 120^\circ\text{C}$ $R_{\theta JA} = 50^\circ\text{C/W}$	<b>MBR1100</b>	0.79 @ 1.0 A	50	150	59-04
20	3	$T_A = 76^\circ\text{C}$ $R_{\theta JA} = 28^\circ\text{C/W}$	<b>1N5820</b>	0.457 @ 3.0 A	80	125	267-03
30	3	$T_A = 71^\circ\text{C}$ $R_{\theta JA} = 28^\circ\text{C/W}$	<b>1N5821</b>	0.500 @ 3.0 A	80	125	267-03
40	3	$T_A = 61^\circ\text{C}$ $R_{\theta JA} = 28^\circ\text{C/W}$	<b>1N5822</b>	0.525 @ 3.0 A	80	125	267-03
40	3	$T_A = 65^\circ\text{C}$ $R_{\theta JA} = 28^\circ\text{C/W}$	<b>MBR340</b>	0.600 @ 3.0 A	80	150	267-03
60	3	$T_A = 65^\circ\text{C}$ $R_{\theta JA} = 28^\circ\text{C/W}$	<b>MBR360</b>	0.740 @ 3.0 A	80	150	267-03
100	3	$T_A = 100^\circ\text{C}$ $R_{\theta JA} = 28^\circ\text{C/W}$	<b>MBR3100</b>	0.79 @ 3.0 A	150	150	267-03

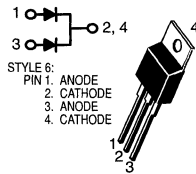
Devices listed in bold, italic are Motorola preferred devices.



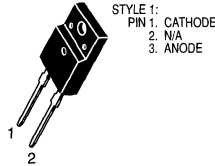
Case 221B  
(TO-220AC)



Case 221A-06  
(TO-220AB)



Case 221E



Case 221D

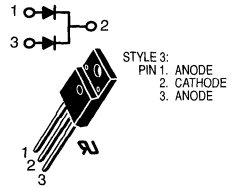


Table 7. TO-220 Type Schottky Rectifiers

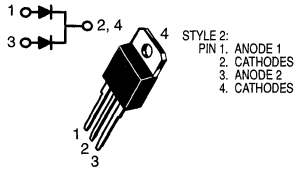
V <sub>RRM</sub> (Volts)	I <sub>O</sub> (Amperes)	I <sub>O</sub> Rating Condition	Device	Max V <sub>F</sub> @ I <sub>F</sub> T <sub>C</sub> = 25°C (Volts)	I <sub>FSM</sub> (Amperes)	T <sub>J</sub> Max (°C)	Case
45	15	T <sub>C</sub> = 105°C	<i>MBR1545CT</i>	0.84 @ 15 A	150	150	221A-06
30	20	T <sub>C</sub> = 137°C	<i>MBR2030CTL</i> ★	0.52 @ 10 A 0.58 @ 20 A	150	150	221A-06
45	20	T <sub>C</sub> = 135°C	<i>MBR2045CT</i>	0.84 @ 20 A	150	150	221A-06
60	20	T <sub>C</sub> = 133°C	<i>MBR2060CT</i>	0.85 @ 10 A 0.95 @ 20 A	150	150	221A-06
100	20	T <sub>C</sub> = 133°C	<i>MBR20100CT</i>	0.85 @ 10 A 0.95 @ 20 A	150	150	221A-06
200	20	T <sub>C</sub> = 125°C	<i>MBR20200CT</i>	1.0 @ 20 A	150	150	221A-06
15	25	T <sub>C</sub> = 90°C	<i>MBR2515L</i> ★	0.45 @ 25 A	150	100	221A-06
35	25	T <sub>C</sub> = 95°C	<i>MBR2535CTL</i> ★	0.55 @ 25 A	150	125	221A-06
45	25	T <sub>C</sub> = 130°C	<i>MBR2545CT</i>	0.82 @ 30 A	150	150	221A-06
45	30	T <sub>C</sub> = 130°C	<i>MBR3045ST</i> ★	0.76 @ 30 A	150	150	221A-06
45	7.5	T <sub>C</sub> = 105°C	<i>MBR745</i>	0.84 @ 15 A	150	150	221B
45	10	T <sub>C</sub> = 135°C	<i>MBR1045</i>	0.84 @ 20 A	150	150	221B
60	10	T <sub>C</sub> = 133°C	<i>MBR1060</i>	0.80 @ 10 A	150	150	221B
100	10	T <sub>C</sub> = 133°C	<i>MBR10100</i>	0.80 @ 10 A	150	150	221B
45	16	T <sub>C</sub> = 125°C	<i>MBR1645</i>	0.63 @ 16 A	150	150	221B
45	15	T <sub>C</sub> = 105°C	Ⓢ <i>MBRF1545CT</i>	0.84 @ 15 A	150	150	ISOLATED 221D
45	20	T <sub>C</sub> = 135°C	Ⓢ <i>MBRF2045CT</i>	0.84 @ 20 A	150	150	ISOLATED 221D
60	20	T <sub>C</sub> = 133°C	Ⓢ <i>MBRF2060CT</i>	0.95 @ 20 A	150	150	ISOLATED 221D
100	20	T <sub>C</sub> = 133°C	Ⓢ <i>MBRF20100CT</i>	0.95 @ 20 A	150	150	ISOLATED 221D
200	20	T <sub>C</sub> = 125°C	Ⓢ <i>MBRF20200CT</i>	1.0 @ 20 A	150	150	ISOLATED 221D
45	25	T <sub>C</sub> = 125°C	Ⓢ <i>MBRF2545CT</i>	0.82 @ 25 A	150	150	ISOLATED 221D
45	7.5	T <sub>C</sub> = 105°C	<i>MBRF745</i> ★	0.84 @ 15 A	150	150	ISOLATED 221E
45	10	T <sub>C</sub> = 135°C	<i>MBRF1045</i> ★	0.84 @ 20 A	150	150	ISOLATED 221E

Ⓢ Indicates UL Recognized — File #E69369

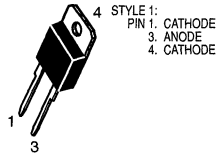
★ New Product

Devices listed in bold, italic are Motorola preferred devices.

Case 340D  
(TO-218AC)



Case 340E  
(TO-218)



Case 340F  
(TO-247)

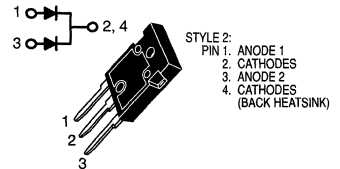
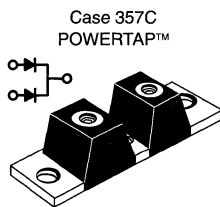


Table 8. TO-218 Types and TO-247 Schottky Rectifiers

VRRM (Volts)	IO (Amperes)	IO Rating Condition	Device	Max VF @ IF TC = 25°C (Volts)	IFSM (Amperes)	TJ Max (°C)	Case
45	30	TC = 105°C	<b>MBR3045PT</b>	0.76 @ 30 A	200	150	340D
45	40	TC = 125°C	<b>MBR4045PT</b>	0.70 @ 20 A 0.80 @ 40 A	400	150	340D
45	60	TC = 125°C	<b>MBR6045PT</b> ★	0.62 @ 30 A 0.75 @ 60 A	500	150	340D
25	50	TC = 125°C	<b>MBR5025L</b> ★	0.54 @ 30 A 0.62 @ 50 A	300	150	340E
45	30	TC = 105°C	<b>MBR3045WT</b>	0.76 @ 30 A	200	150	340F
15	40	TC = 125°C	<b>MBR4015LWT</b>	0.42 @ 20 A 0.50 @ 40 A	400	150	340F
45	40	TC = 125°C	<b>MBR4045WT</b>	0.70 @ 20 A 0.80 @ 40 A	400	150	340F
45	60	TC = 125°C	<b>MBR6045WT</b>	0.62 @ 30 A 0.75 @ 60 A	500	150	340F
30	70	TC = 135°C	<b>MBR7030WT</b>	0.55 @ 35 A 0.72 @ 70 A	400	150	340F

★ New Product

Devices listed in bold, italic are Motorola preferred devices.



Cathode = Mounting Plate  
Anode = Terminal

**Table 9. POWERTAP II**

V <sub>RRM</sub> (Volts)	I <sub>O</sub> (1) (Amperes)	I <sub>O</sub> Rating Condition	Device	Max V <sub>F</sub> @ i <sub>F</sub> T <sub>C</sub> = 25°C (Volts)	I <sub>FSM</sub> (Amperes)	T <sub>J</sub> Max (°C)	Case
30	200	T <sub>C</sub> = 125°C	<b><i>MBRP20030CTL</i></b> ★	0.52 @ 100 A 0.60 @ 200 A	1500	150	357C
45	200	T <sub>C</sub> = 125°C	<b><i>MBRP20045CT</i></b> ★	0.78 @ 100 A	1500	175	357C
60	200	T <sub>C</sub> = 125°C	<b><i>MBRP20060CT</i></b> ★	0.800 @ 100 A	1500	175	357C
45	300	T <sub>C</sub> = 120°C	<b><i>MBRP30045CT</i></b> ★	0.70 @ 150 A 0.82 @ 300 A	2500	175	357C
60	300	T <sub>C</sub> = 120°C	<b><i>MBRP30060CT</i></b> ★	0.79 @ 150 A 0.89 @ 300 A	2500	175	357C
35	600	T <sub>C</sub> = 100°C	<b><i>MBRP60035CTL</i></b> ★	0.57 @ 300 A	4000	150	357C

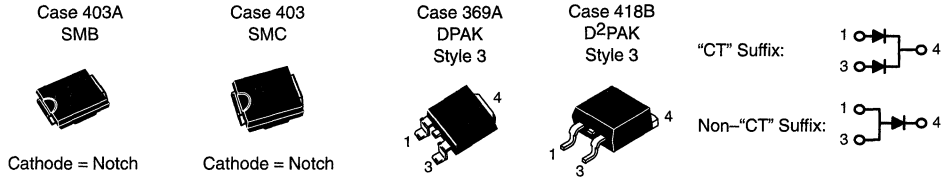
(1) I<sub>O</sub> is total device current capability.

All POWERTAP devices were converted to the new, more rugged, POWERTAP II configuration beginning January 1994. Contact your Motorola representative for more details.

★ New Product

Devices listed in bold, italic are Motorola preferred devices.

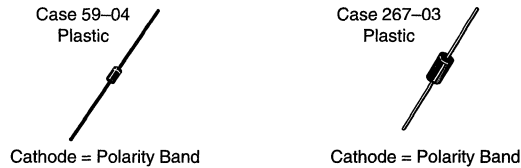
# Ultrafast Rectifiers



**Table 10. Surface Mount Ultrafast Rectifiers**

V <sub>RRM</sub> (Volts)	I <sub>O</sub> (1) (Amperes)	I <sub>O</sub> Rating Condition	Device	Max t <sub>rr</sub> (ns)	Max V <sub>F</sub> @ i <sub>F</sub> T <sub>C</sub> = 25°C (Volts)	I <sub>FSM</sub> (Amperes)	T <sub>J</sub> Max (°C)	Package
200	1	T <sub>L</sub> = 155°C	<b>MURS120T3</b>	35	0.875 @ 1.0 A	40	175	SMB
600	1	T <sub>L</sub> = 150°C	<b>MURS160T3</b>	75	1.25 @ 1.0 A	35	175	SMB
200	3	T <sub>L</sub> = 140°C	<b>MURS320T3</b>	35	0.875 @ 3.0 A	75	175	SMC
600	3	T <sub>L</sub> = 130°C	<b>MURS360T3</b>	75	1.25 @ 3.0 A	75	175	SMC
200	3	T <sub>L</sub> = 158°C	<b>MURD320</b>	35	0.95 @ 3.0 A	75	175	DPAK
200	6	T <sub>L</sub> = 145°C	<b>MURD620CT</b>	35	1.0 @ 3.0 A	63	175	DPAK
400	8	T <sub>L</sub> = 120°C	<b>MURHB840CT</b> ★	28	2.2 @ 4.0 A	100	175	D <sup>2</sup> PAK
200	16	T <sub>L</sub> = 150°C	<b>MURB1620CT</b>	35	0.975 @ 8.0 A	100	175	D <sup>2</sup> PAK
600	16	T <sub>L</sub> = 150°C	<b>MURB1660CT</b>	60	1.5 @ 8.0 A	100	175	D <sup>2</sup> PAK

(1) I<sub>O</sub> is total device current capability.  
★ New Product

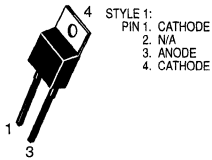


**Table 11. Axial Lead Ultrafast Rectifiers**

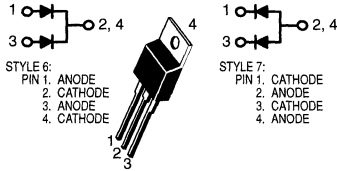
V <sub>RRM</sub> (Volts)	I <sub>O</sub> (Amperes)	I <sub>O</sub> Rating Condition	Device	Max t <sub>rr</sub> (ns)	Max V <sub>F</sub> @ i <sub>F</sub> T <sub>C</sub> = 25°C (Volts)	I <sub>FSM</sub> (Amperes)	T <sub>J</sub> Max (°C)	Case
200	1	T <sub>A</sub> = 130°C R <sub>θJA</sub> = 50°C/W	<b>MUR120</b>	25	0.875 @ 1.0 A	35	175	59-04
600	1	T <sub>A</sub> = 120°C R <sub>θJA</sub> = 50°C/W	<b>MUR160</b>	50	1.25 @ 1.0 A	35	175	59-04
1000	1	T <sub>A</sub> = 95°C R <sub>θJA</sub> = 50°C/W	<b>MUR1100E</b>	75	1.75 @ 1.0 A	35	175	59-04
200	4	T <sub>A</sub> = 80°C R <sub>θJA</sub> = 28°C/W	<b>MUR420</b>	25	0.875 @ 3.0 A	125	175	267-03
600	4	T <sub>A</sub> = 40°C R <sub>θJA</sub> = 28°C/W	<b>MUR460</b>	50	1.25 @ 3.0 A	70	175	267-03
1000	4	T <sub>A</sub> = 35°C R <sub>θJA</sub> = 28°C/W	<b>MUR4100E</b>	75	1.75 @ 3.0 A	70	175	267-03

Devices listed in bold, italic are Motorola preferred devices.

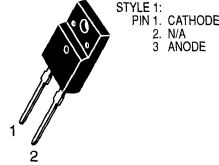
Case 221B  
(TO-220AC)



Case 221A-06  
(TO-220AB)



Case 221E



Case 221D

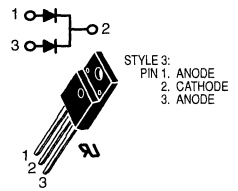





Table 12. TO-220 Type Ultrafast Rectifiers

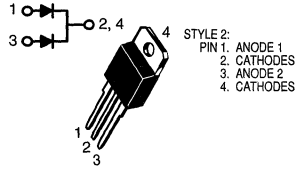
$V_{RRM}$ (Volts)	$I_O$ (Amperes)	$I_O$ Rating Condition	Device	Max $t_{rr}$ (ns)	Max $V_F$ @ $i_F$ $T_C = 25^\circ\text{C}$ (Volts)	$I_{FSM}$ (Amperes)	$T_J$ Max ( $^\circ\text{C}$ )	Case
200	6	$T_C = 130^\circ\text{C}$	<i>MUR620CT</i>	35	0.975 @ 3.0 A	75	175	221A-06
400	8	$T_C = 120^\circ\text{C}$	<i>MURH840CT</i>	28	2.0 @ 4.0 A	100	175	221A-06
600	8	$T_C = 120^\circ\text{C}$	<i>MURH860CT</i>	35	2.8 @ 4.0 A	100	175	221A-06
200	16	$T_C = 150^\circ\text{C}$	<i>MUR1620CT</i>	35	0.975 @ 8.0 A	100	175	221A-06
200	16	$T_C = 160^\circ\text{C}$	<i>MUR1620CTR</i>	85	1.2 @ 8.0 A	100	175	221A-06
400	16	$T_C = 150^\circ\text{C}$	<i>MUR1640CT</i>	60	1.30 @ 8.0 A	100	175	221A-06
600	16	$T_C = 150^\circ\text{C}$	<i>MUR1660CT</i>	60	1.5 @ 8.0 A	100	175	221A-06
200	8	$T_C = 150^\circ\text{C}$	<i>MUR820</i>	35	0.975 @ 8.0 A	100	175	221B
400	8	$T_C = 150^\circ\text{C}$	<i>MUR840</i> ★	50	1.30 @ 8.0 A	100	175	221B
600	8	$T_C = 150^\circ\text{C}$	<i>MUR860</i> ★	50	1.50 @ 8.0 A	100	175	221B
800	8	$T_C = 175^\circ\text{C}$	<i>MUR880E</i>	75	1.80 @ 8.0 A	100	175	221B
1000	8	$T_C = 150^\circ\text{C}$	<i>MUR8100E</i>	75	1.80 @ 8.0 A	100	175	221B
1200	10	$T_C = 125^\circ\text{C}$	<i>MUR10120E</i>	175	2.2 @ 6.5 A	100	125	221B
1500	10	$T_C = 125^\circ\text{C}$	<i>MUR10150E</i>	175	2.4 @ 6.5 A	100	125	221B
200	15	$T_C = 150^\circ\text{C}$	<i>MUR1520</i>	35	1.05 @ 15 A	200	175	221B
400	15	$T_C = 150^\circ\text{C}$	<i>MUR1540</i>	60	1.25 @ 15 A	150	175	221B
600	15	$T_C = 145^\circ\text{C}$	<i>MUR1560</i>	60	1.50 @ 15 A	150	175	221B
200	8	$T_C = 150^\circ\text{C}$	<i>MURF820</i> ★	25	0.975 @ 8.0 A	100	150	ISOLATED 221E
200	16	$T_C = 150^\circ\text{C}$	 <i>MURF1620CT</i> ★	25	0.975 @ 8.0 A	100	150	ISOLATED 221D
600	16	$T_C = 150^\circ\text{C}$	 <i>MURF1660CT</i> ★	50	1.50 @ 8.0 A	100	150	ISOLATED 221D

 Indicates UL Recognized — File #E69369

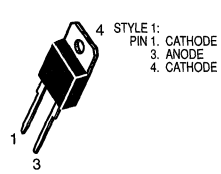
★ New Product

Devices listed in bold, italic are Motorola preferred devices.

Case 340D  
(TO-218AC)



Case 340E  
(TO-218)



Case 340F  
(TO-247)

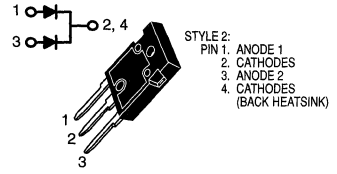


Table 13. TO-218 Types and TO-247 Ultrafast Rectifiers

V <sub>RRM</sub> (Volts)	I <sub>O</sub> (Amperes)	I <sub>O</sub> Rating Condition	Device	Max t <sub>rr</sub> (ns)	Max V <sub>F</sub> @ i <sub>F</sub> T <sub>C</sub> = 25°C (Volts)	I <sub>FSM</sub> (Amperes)	T <sub>J</sub> Max (°C)	Case
200	30	T <sub>C</sub> = 145°C	<b>MUR3020WT</b>	35	1.05 @ 15 A	150	175	340F
400	30	T <sub>C</sub> = 145°C	<b>MUR3040WT</b>	60	1.25 @ 15 A	150	175	340F
600	30	T <sub>C</sub> = 145°C	<b>MUR3060WT</b>	60	1.70 @ 15 A	150	175	340F
200	30	T <sub>C</sub> = 150°C	<b>MUR3020PT</b>	35	1.12 @ 15 A	200	175	340D
400	30	T <sub>C</sub> = 150°C	<b>MUR3040PT</b>	60	1.12 @ 15 A	150	175	340D
600	30	T <sub>C</sub> = 145°C	<b>MUR3060PT</b>	60	1.20 @ 15 A	150	175	340D
400	30	T <sub>C</sub> = 70°C	<b>MUR3040</b> ★	100	1.5 @ 30 A	300	175	340E
800	30	T <sub>C</sub> = 70°C	<b>MUR3080</b> ★	110	1.90 @ 30 A	300	175	340E
400	60	T <sub>C</sub> = 70°C	<b>MUR6040</b>	100	1.50 @ 60 A	600	175	340E

★ New Product

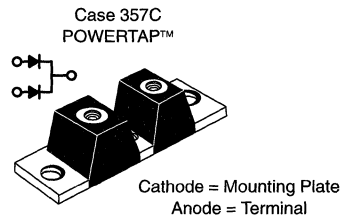


Table 14. POWER TAP II

V <sub>RRM</sub> (Volts)	I <sub>O</sub> (1) (Amperes)	I <sub>O</sub> Rating Condition	Device	Max t <sub>rr</sub> (ns)	Max V <sub>F</sub> @ i <sub>F</sub> T <sub>C</sub> = 25°C (Volts)	I <sub>FSM</sub> (Amperes)	T <sub>J</sub> Max (°C)	Case
200	200	T <sub>C</sub> = 130°C	<b>MURP20020CT</b> ★	50	1.00 @ 100 A	800	175	357C
400	200	T <sub>C</sub> = 100°C	<b>MURP20040CT</b> ★	50	1.30 @ 100 A	800	175	357C

(1) I<sub>O</sub> is total device current capability.

All POWER TAP devices were converted to the new, more rugged, POWER TAP II configuration beginning January 1994. Contact your Motorola representative for more details.

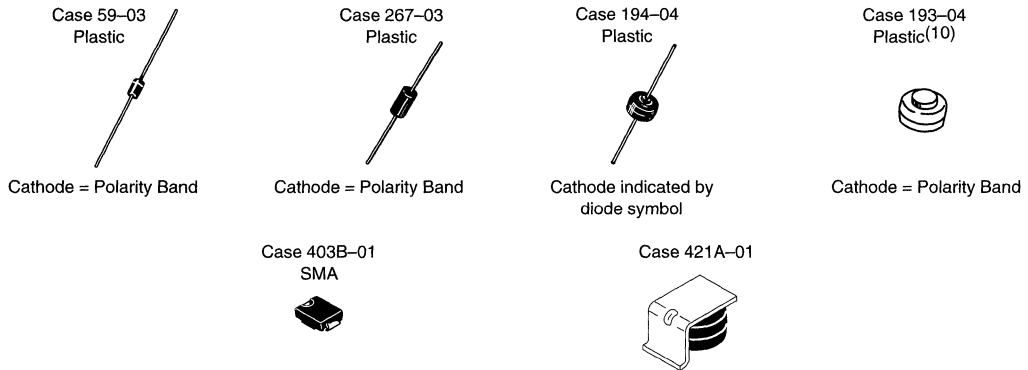
UL Indicates UL Recognized — File #E69369

★ New Product

Devices listed in bold, italic are Motorola preferred devices.

# Fast Recovery Rectifiers/General-Purpose Rectifiers

Axial lead Fast Recovery Rectifiers having maximum switching times of 200 ns and low cost general purpose rectifiers are listed in the table below.



**Table 15. Fast Recovery Rectifiers/General Purpose Rectifiers**

V <sub>RRM</sub> (Volts)	I <sub>O</sub> (Amperes)	I <sub>O</sub> Rating Condition	Device	Max V <sub>F</sub> @ I <sub>F</sub> T <sub>J</sub> = 25°C (Volts)	Max t <sub>rr</sub> (ns)	I <sub>FSM</sub> (Amperes)	T <sub>J</sub> Max (°C)	Case
200	1	T <sub>C</sub> = 100°C	<b>MRA4003</b>	1.1 @ 1.0 A	—	30	150	403B-01
400	1	T <sub>C</sub> = 100°C	<b>MRA4004</b>	1.1 @ 1.0 A	—	30	150	
600	1	T <sub>C</sub> = 100°C	<b>MRA4005</b>	1.1 @ 1.0 A	—	30	150	
800	1	T <sub>C</sub> = 100°C	<b>MRA4006</b>	1.1 @ 1.0 A	—	30	150	
1000	1	T <sub>C</sub> = 100°C	<b>MRA4007</b>	1.1 @ 1.0 A	—	30	150	
400	1	T <sub>A</sub> = 75°C	<b>1N4004</b>	1.1 @ 1.0 A	—	30	150	59-03(9)
1000	1	T <sub>A</sub> = 75°C	<b>1N4007</b>	1.1 @ 1.0 A	—	30	150	
200	1	T <sub>A</sub> = 75°C	<b>1N4935</b>	1.2 @ 3.14 A T <sub>J</sub> = 125°C	200	30	150	
600	1	T <sub>A</sub> = 75°C	<b>1N4937</b>	1.2 @ 3.14 A T <sub>J</sub> = 125°C	200	30	150	
400	3	T <sub>L</sub> = 105°C	<b>1N5404</b>	1.2 @ 9.4 A	—	200	150	267-03
600	3	T <sub>L</sub> = 105°C	<b>1N5406</b>	1.2 @ 9.4 A	—	200	150	
200	3	T <sub>A</sub> = 80°C(10)	<b>MR852</b>	1.25 @ 3.0 A	200	100	150	
600	3	T <sub>A</sub> = 80°C(10)	<b>MR856</b>	1.25 @ 3.0 A	200	100	150	194-04
400	6	T <sub>A</sub> = 60°C R <sub>θJA</sub> = 25°C/W	<b>MR754</b>	1.25 @ 100 A	—	400	175	
1000	6	T <sub>A</sub> = 60°C R <sub>θJA</sub> = 25°C/W	<b>MR760</b>	1.25 @ 100 A	—	400	175	
400	25	T <sub>C</sub> = 150°C	<b>MR2504</b>	1.18 @ 78.5 A	—	400	175	193-04
1000	25	T <sub>C</sub> = 150°C	<b>MR2510</b>	1.18 @ 78.5 A	—	400	175	
20	35	T <sub>C</sub> = 150°C	<b>MR2535S</b>	1.1 @ 100 A	—	400	175	421A-01
20	35	T <sub>C</sub> = 150°C	<b>MR2535L(11)</b>	1.1 @ 100 A	—	400	175	194-04
200	1	T <sub>L</sub> = 100°C	<b>MRA4935T3</b>	1.1 @ 1.0 A	200	30	150	403B-01
400	1	T <sub>L</sub> = 100°C	<b>MRA4936T3</b>	1.1 @ 1.0 A	200	30	150	
600	1	T <sub>L</sub> = 100°C	<b>MRA4937T3</b>	1.1 @ 1.0 A	200	30	150	

(2) V<sub>RRM</sub> unless noted

(3) V<sub>RRM</sub>, T<sub>J</sub> = 100°C unless noted

(9) Package Size: 0.120" max diameter by 0.260" length.

(10) Must be derated for reverse power dissipation. See data sheet.

(11) Overvoltage Transient Suppressor: 24–32 volts avalanche voltage.

Devices listed in bold, italic are Motorola preferred devices.

# GaAs Rectifiers Power Manager™

For use in state-of-the-art high power density DC-DC converters and high frequency power supplies, GaAs power rectifiers have several unique characteristics that make them superior to Si-based devices. In particular, GaAs devices are acclaimed for their hyperfast and soft reverse recovery characteristics with low stored charge. Also, the device parameters are stable over a wide temperature range.

GaAs devices as drop-in replacements for Si may eliminate the need for a snubber network or allow for a significant reduction in network size. Performance improvements can therefore be achieved while reducing circuit size (increasing power density), decreasing EMI, and enhancing overall system efficiency.

**Table 16. TO-220 and D<sup>2</sup>PAK GaAs Rectifiers Power Manager™**

V <sub>RRM</sub> (Volts)	I <sub>DC</sub> (12)	I <sub>DC</sub> Rating Condition	Device	Max V <sub>F</sub> @ 10 A T <sub>C</sub> = 25°C (Volts)	Max t <sub>rr</sub> (ns)	Case
180	10	T <sub>C</sub> = 110°C	<b><i>MGR1018</i></b> ★	1.4	15	221A-06
180	10	T <sub>C</sub> = 110°C	<b><i>MGRB1018</i></b> ★	1.4	15	418B
180	20	T <sub>C</sub> = 130°C	<b><i>MGR2018CT</i></b> ★	1.4	15	221A-06
180	20	T <sub>C</sub> = 130°C	<b><i>MGRB2018CT</i></b> ★	1.4	15	418B
250	20	T <sub>C</sub> = 95°C	<b><i>MGR2025CT</i></b> ★	2.2	15	221A-06
250	20	T <sub>C</sub> = 95°C	<b><i>MGRB2025CT</i></b> ★	2.2	15	418B

(12) I<sub>DC</sub> is total device current capability.

★ New Product

Case 418B available in reel of 800 "T4".

Devices listed in bold, italic are Motorola preferred devices.



# Thyristors and Triggers

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## In Brief . . .

Motorola's broad line of Thyristors includes. . . .

- A full line of TRIACs and SCRs covering a forward current range from 0.5 to 55 amperes and blocking voltages from 15 to 800 volts.
- Plastic package for lowest cost which includes the fully insulated plastic Case 221C (TO-220 Isolated).
- An extensive line of trigger devices that includes SIDACs, PUTs and SBS.

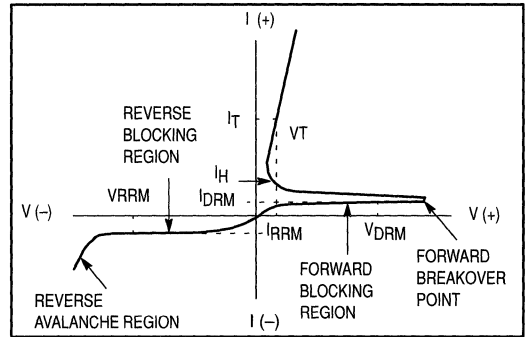
Then there are the special applications devices for Ignition circuits and Crowbar applications. Also included are isolated packaged devices for appliances and surface mount packages for surface mounting in space-saving requirements.

Finally, there is the continued Motorola investment in discrete-product R & D producing new capabilities such as transient SIDACs for use in circuits sensitive to high voltage transients.

	<b>Page</b>
Silicon Controlled Rectifiers . . . . .	5.7-2
TRIACs . . . . .	5.7-7
General Purpose . . . . .	5.7-7
Thyristor Triggers . . . . .	5.7-14
SIDACs . . . . .	5.7-14
Programmable Unijunction Transistors — PUT . .	5.7-14
Silicon Bidirectional Switch (SBS) . . . . .	5.7-14
High Voltage Bidirectional TVS Devices . . . . .	5.7-14

# SCRs

## Silicon Controlled Rectifiers



**Table 1. SCRs — General Purpose Plastic Packages  
0.8 to 55 Amperes RMS, 25 to 800 Volts**

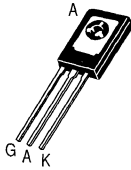
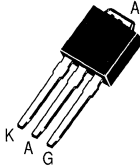
On-State (RMS) Current			V <sub>DRM</sub> V <sub>RRM</sub> (Volts)
0.8 AMP		1.5 AMPS	
T <sub>C</sub> = 58°C	T <sub>C</sub> = 80°C	T <sub>C</sub> = 50°C	
Sensitive Gate			
Case 29-04 TO-226AA (TO-92) Style 10	Case 318E SOT-223 STYLE 10	Case 29-04 TO-226AA (TO-92) Style 10	
			25
			50
			100
	<i>MCR08BT1</i>		200
<i>MCR100-6</i>	<i>MCR08DT1</i>	<i>MCR22-6</i>	400
			500
<i>MCR100-8</i>	<i>MCR08MT1</i>	<i>MCR22-8</i>	600
Maximum Electrical Characteristics			
10	10	15 150(3)	I <sub>TSM</sub> (Amps) 60 Hz
	0.2		I <sub>GT</sub> (mA)
	0.8		V <sub>GT</sub> (V)
-65 to +110	-40 to +110	-40 to +125	T <sub>J</sub> Operating Range (°C)


(3) Exponential decay 2 μs wide at 5 time constants, f = 12 Hz.

Devices listed in bold, italic are Motorola preferred devices.

# SCRs (continued)

Table 1. SCRs — General Purpose Plastic Packages (continued)

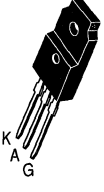
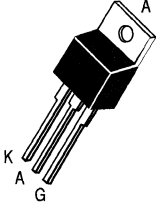
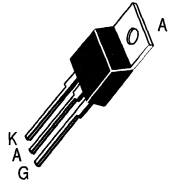
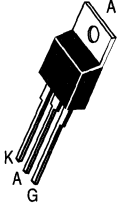

$V_{DRM}$ $V_{RRM}$ (Volts)	On-State (RMS) Current			
	4 AMPS			
	$T_C = 93^\circ\text{C}$		$T_C = 30^\circ\text{C}$	
				
	Sensitive Gate			Surface Mount
	Case 77 TO-225AA (TO-126) Style 2		Case 369 Style 4	Case 369A Style 4
50	<i>MCR106-2</i> <i>2N6237</i>	<i>C106F</i>		
100	<i>MCR106-3</i> <i>2N6238</i>	<i>C106A</i>		
200	<i>MCR106-4</i> <i>2N6239</i>	<i>C106B</i>		
400	<i>MCR106-6</i> <i>2N6240</i>	<i>C106D</i>	MCR716-1	MCR716
600	<i>MCR106-8</i> <i>2N6241</i>	<i>C106M</i>	MCR718-1	MCR718
800				
Maximum Electrical Characteristics				
$I_{TSM}$ (Amps) 60 Hz	25	20	25	
$I_{GT}$ (mA)	0.2		0.075	
$V_{GT}$ (V)	1	0.8	1	
$T_J$ Operating Range ( $^\circ\text{C}$ )	-40 to +110			


 Indicates UL Recognized — File #E69369

Devices listed in bold, italic are Motorola preferred devices.

# SCRs (continued)

**Table 1. SCRs — General Purpose Plastic Packages (continued)**

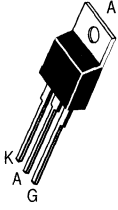
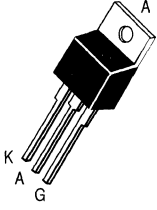
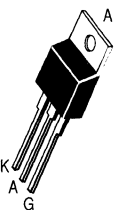
On-State (RMS) Current					V <sub>DRM</sub> V <sub>RRM</sub> (Volts)
8 AMPS				10 AMPS	
T <sub>C</sub> = 70°C	T <sub>C</sub> = 83°C	T <sub>C</sub> = 80°C		T <sub>C</sub> = 75°C	
					
High Performance					
Isolated 	Sensitive Gate	Sensitive Gate			
Case 221C-02 Style 2	Case 221A-04 TO-220AB Style 3	Case 221A-06 TO-220AB Style 3		Case 221A-04 TO-220AB Style 3	
	MCR72-2			50	
	MCR72-3			MCR310-3 100	
MCR218-4FP	MCR72-4			MCR310-4 200	
MCR218-6FP	MCR72-6	<i>MCR8D</i>	<i>MCR8SD</i>	MCR310-6 400	
MCR218-8FP	MCR72-8	<i>MCR8M</i>	<i>MCR8SM</i>	MCR310-8 600	
MCR218-10FP	MCR72-10	<i>MCR8N</i>	<i>MCR8SN</i>	MCR310-10 800	
Maximum Electrical Characteristics					
80	100	80		I <sub>TSM</sub> (Amps) 60 Hz	
25	0.2	15	0.2	I <sub>GT</sub> (mA)	
1.5		1		V <sub>GT</sub> (V)	
		Min.	Min.	DV/DT V/μsec	
		50	2		
-40 to +125	-40 to +110	-40 to +125	-40 to +110	T <sub>J</sub> Operating Range (°C)	

 Indicates UL Recognized — File #E69369

Devices listed in bold, italic are Motorola preferred devices.

# SCRs (continued)

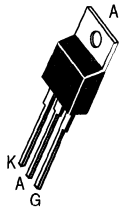
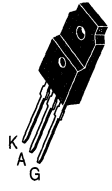
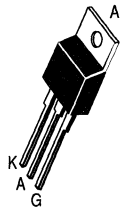
Table 1. SCRs — General Purpose Plastic Packages (continued)

$V_{DRM}$ $V_{RRM}$ (Volts)	On-State (RMS) Current				
	10 AMPS	12 AMPS	16 AMPS	25 AMPS	
	$T_C = 75^\circ\text{C}$		$T_C = 80^\circ\text{C}$		$T_C = 85^\circ\text{C}$
					
	Sensitive Gate	High Performance			
Case 221A-04 TO-220AB Style 3	Case 221A-06 TO-220AB Style 3			Case 221A-04 TO-220AB Style 3	
50					2N6504
100					2N6505
200					2N6506
400	MCR12LD	<i>MCR12D</i>	<i>MCR16D</i>	<i>MCR25D</i>	2N6507
600	MCR12LM	<i>MCR12M</i>	<i>MCR16M</i>	<i>MCR25M</i>	2N6508
800	MCR12LN	<i>MCR12N</i>	<i>MCR16N</i>	<i>MCR25N</i>	2N6509
Maximum Electrical Characteristics					
$I_{TSM}$ (Amps) 60 Hz	100		150	300	
$I_{GT}$ (mA)	8	20		30	40
$V_{GT}$ (V)	1.5	2.2	1.7	1	1.5
$DV/DT$ $V/\mu\text{sec}$	Min.	Min.	Min.	Min.	
	50	50	50	50	
$T_J$ Operating Range ( $^\circ\text{C}$ )	-40 to +100		-40 to +125		


Devices listed in bold, italic are Motorola preferred devices.

# SCRs (continued)

**Table 1. SCRs — General Purpose Plastic Packages (continued)**

On-State (RMS) Current				V <sub>DRM</sub> V <sub>RRM</sub> (Volts)
25 AMPS		40 AMPS	55 AMPS	
T <sub>C</sub> = 85°C		T <sub>C</sub> = 80°C	T <sub>C</sub> = 70°C	
				
Case 221A-04 TO-220AB Style 3	Case 221C-02 Style 2	Case 221A-04 TO-220AB Style 3		
MCR69-2	MCR225-2FP			50
MCR69-3				100
	MCR225-4FP	<i>MCR264-4</i>	<i>MCR265-4</i>	200
MCR69-6	MCR225-6FP	<i>MCR264-6</i>	<i>MCR265-6</i>	400
	MCR225-8FP	<i>MCR264-8</i>	<i>MCR265-8</i>	600
	MCR225-10FP	<i>MCR264-10</i>	<i>MCR265-10</i>	800
Maximum Electrical Characteristics				
750 <sup>(2)</sup>	300	400	550	I <sub>TSM</sub> (Amps) 60 Hz
30	40	50		I <sub>GT</sub> (mA)
1.5				V <sub>GT</sub> (V)
-40 to +125				T <sub>J</sub> Operating Range (°C)

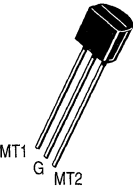
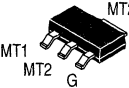
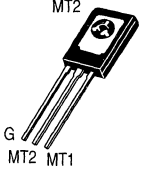
(2) Peak capacitor discharge current for  $t_w = 1$  ms.  $t_w$  is defined as five time constants of an exponentially decaying current pulse (crowbar applications).

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Devices listed in bold, italic are Motorola preferred devices.

# TRIACs

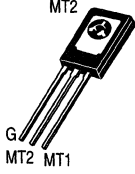
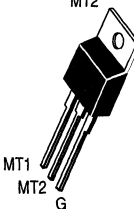
Table 2. TRIACs — General Purpose Plastic Packages  
0.6 to 40 Amperes, 200 to 800 Volts

V <sub>DRM</sub> (Volts)	On-State (RMS) Current			
	0.6 AMP		0.8 AMPS	2.5 AMPS
	T <sub>C</sub> = 50°C		T <sub>C</sub> = 80°C	T <sub>C</sub> = 70°C
				
	Sensitive Gate			
Case 29-04 TO-225AA (TO-92) Style 12		Case 318E Style 11 SOT-223	Case 77 TO-225AA (TO-126) Style 5	
200			<i>MAC08BT1</i>	<i>T2322B</i>
400	<i>MAC97-6</i>	<i>MAC97A6</i>	<i>MAC08DT1</i>	<i>T2322D</i>
600	<i>MAC97-8</i>	<i>MAC97A8</i>	<i>MAC08MT1</i>	<i>T2322M</i>
Maximum Electrical Characteristics				
I <sub>TSM</sub> (Amps)	8		10	25
I <sub>GT</sub> @ 25°C (mA)				
MT2(+)/G(+)	10	5	10	10
MT2(+)/G(-)	10	5	10	10
MT2(-)/G(-)	10	5	10	10
MT2(-)/G(+)	10	7	10	10
V <sub>GT</sub> @ 25°C (V)			0.8	
MT2(+)/G(+)	2		2	2.2
MT2(+)/G(-)	2		2	2.2
MT2(-)/G(-)	2		2	2.2
MT2(-)/G(+)	2.5		2	2.2
T <sub>J</sub> Operating Range (°C)	-40 to +110			

Devices listed in bold, italic are Motorola preferred devices.

# TRIACs (continued)

Table 2. TRIACs (continued)

On-State (RMS) Current					
2.5 AMPS	4 AMPS			6 AMPS	
T <sub>C</sub> = 70°C	T <sub>C</sub> = 85°C			T <sub>C</sub> = 80°C	
					
Sensitive Gate					V <sub>DRM</sub> (Volts)
Case 77 TO-225AA (TO-126) Style 5			Case 221A-04 TO-220AB Style 4		
<i>T2323B</i>	<i>2N6071</i>	<i>2N6071A</i>	<i>2N6071B</i>	T2500B	200
<i>T2323D</i>	<i>2N6073</i>	<i>2N6073A</i>	<i>2N6073B</i>	T2500D	400
<i>T2323M</i>	<i>2N6075</i>	<i>2N6075A</i>	<i>2N6075B</i>	T2500M	600
				T2500N	800
Maximum Electrical Characteristics					
25	30			60	I <sub>TSM</sub> (Amps)
25	30	5	3	25	I <sub>GT</sub> @ 25°C (mA) MT2(+) G(+) MT2(+) G(-) MT2(-) G(-) MT2(-) G(+)
40	—	5	3	60	
25	30	5	3	25	
40	—	10	5	60	
2.2	@ -40°C 2.5	@ -40°C 2.5		2.5	V <sub>GT</sub> @ 25°C (V) MT2(+) G(+) MT2(+) G(-) MT2(-) G(-) MT2(-) G(+)
2.2	—	2.5		2.5	
2.2	2.5	2.5		2.5	
2.2	—	2.5		2.5	
-40 to +110		-40 to +100			T <sub>J</sub> Operating Range (°C)

Devices listed in bold, italic are Motorola preferred devices.



# TRIACs (continued)

Table 2. TRIACs (continued)

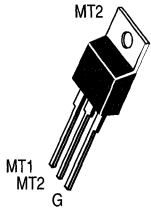
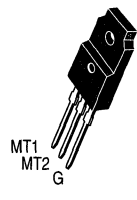

V <sub>DRM</sub> (Volts)	On-State (RMS) Current						
	6 AMPS		8 AMPS				
	T <sub>C</sub> = 80°C	T <sub>C</sub> = 80°C	T <sub>C</sub> = 70°C	T <sub>C</sub> = 80°C			
	Isolated	Sensitive Gate			High Performance	Isolated	
Case 221C-02 Style 3	Case 221A-04 TO-220AB Style 4	Case 221A-06 TO-220AB Style 4			Case 221C-02 Style 3		
200	T2500BFP	MAC218A4				MAC218A4FP	
400	T2500DFP	MAC218A6	<b>MAC8SD</b>	<b>MAC8D</b>	<b>MAC9D</b>	MAC218A6FP	
600	T2500MFP	MAC218A8	<b>MAC8SM</b>	<b>MAC8M</b>	<b>MAC9M</b>	MAC218A8FP	
800	T2500NFP	MAC218A10	<b>MAC8SN</b>	<b>MAC8N</b>	<b>MAC9N</b>	MAC218A10FP	
Maximum Electrical Characteristics							
I <sub>TSM</sub> (Amps)	100		70		80		100
I <sub>GT</sub> @ 25°C (mA)			Min.	Max.			
MT2(+)G(+)	25	50	0.8	5.0	35	50	50
MT2(+)G(-)	60	50	0.8	5.0	35	50	50
MT2(-)G(-)	25	50	0.8	5.0	35	50	50
MT2(-)G(+)	60	75(1)	—	—	—	—	75(1)
V <sub>GT</sub> @ 25°C (V)							
MT2(+)G(+)	2.5	2	0.45	1.5	1.5		2
MT2(+)G(-)	2.5	2	0.45	1.5	1.5		2
MT2(-)G(-)	2.5	2	0.45	1.5	1.5		2
MT2(-)G(+)	2.5	2.5(1)	—	—	—		2.5(1)
DV/DT V/μsec			Min.		Min.	Min.	
			25		250	500	
T <sub>J</sub> Operating Range (°C)	-40 to +100	-40 to +125	-40 to +110		-40 to +125		

Indicates UL Recognized — File #E69369

Devices listed in bold, italic are Motorola preferred devices.

# TRIACs (continued)

**Table 2. TRIACs (continued)**

On-State (RMS) Current					
8 AMPS					
$T_C = 80^\circ\text{C}$					
					
		Isolated 			
		Sensitive Gate		$V_{DRM}$ (Volts)	
Case 221A-04 TC-220AB Style 4		Case 221C-02 Style 3			
2N6342 2N6346	T2800B	MAC228A4	MAC228A4FP		200
2N6343 2N6347	T2800D	MAC228A6	MAC228A6FP		400
2N6344 2N6348	T2800M	MAC228A8	MAC228A8FP		600
2N6345 2N6349		MAC228A10	MAC228A10FP	800	
Maximum Electrical Characteristics					
100		80		$I_{TSM}$ (Amps)	
50 75(6) 50 75(6)	25 60 25 60	5 5 5 10(1)	5 5 5 10(1)	$I_{GT}$ @ 25°C (mA) MT2(+)G(+) MT2(+)G(-) MT2(-)G(-) MT2(-)G(+)	
2 2.5(6) 2.5 2.5(6)	2.5 2.5 2.5 2.5	2 2 2 2.5(1)		$V_{GT}$ @ 25°C (V) MT2(+)G(+) MT2(+)G(-) MT2(-)G(-) MT2(-)G(+)	
-40 to +125	-40 to +100	-40 to +110		$T_J$ Operating Range (°C)	

(6) Denotes 2N6346-49 Series only.

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# TRIACs (continued)

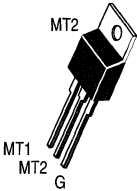
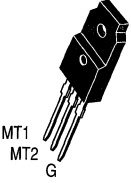

Table 2. TRIACs (continued)


V <sub>DRM</sub> (Volts)	On-State (RMS) Current				
	10 AMPS			12 AMPS	
	T <sub>C</sub> = 70°C		T <sub>C</sub> = 75°C	T <sub>C</sub> = 85°C	
	Case 221A-04 TO-220AB Style 4	Case 221C-02 Style 3	Case 221A-04 TO-220AB Style 4	Case 221C-02 Style 3	Case 221A-04 TO-220AB Style 4
200	MAC210A4	MAC210A4FP	MAC310A4	MAC212A4FP	MAC212A4
400	MAC210A6	MAC210A6FP	MAC310A6	MAC212A6FP	MAC212A6
600	MAC210A8	MAC210A8FP	MAC310A8	MAC212A8FP	MAC212A8
800	MAC210A10	MAC210A10FP	MAC310A10	MAC212A10FP	MAC212A10
Maximum Electrical Characteristics					
I <sub>TSM</sub> (Amps)	100				
I <sub>GT</sub> @ 25°C (mA)					
MT2(+)/G(+)	50		5		50
MT2(+)/G(-)	50		5		50
MT2(-)/G(-)	50		5		50
MT2(-)/G(+)	75(1)		10(1)		75(1)
V <sub>GT</sub> @ 25°C (V)					
MT2(+)/G(+)			2		
MT2(+)/G(-)			2		
MT2(-)/G(-)			2		
MT2(-)/G(+)			2.5(1)		
T <sub>J</sub> Operating Range (°C)			-40 to +125		

Indicates UL Recognized — File #E69369

# TRIACs (continued)

Table 2. TRIACs (continued)

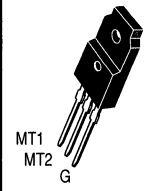
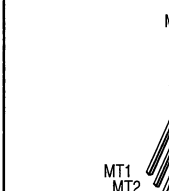
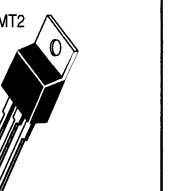
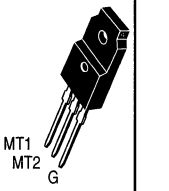
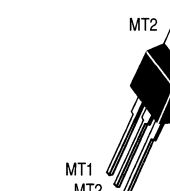

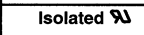

On-State (RMS) Current								
12 AMPS			15 AMPS					
T <sub>C</sub> = 80°C			T <sub>C</sub> = 70°C	T <sub>C</sub> = 90°C	T <sub>C</sub> = 80°C	T <sub>C</sub> = 90°C		
				Sensitive Gate				
High Performance				High Performance		Isolated 		
Case 221A-04 TO-220AB Style 4	Case 221A-06 TO-220AB Style 4			Case 221A-04 TO-220AB Style 4	Case 221A-06 TO-220AB Style 4	Case 221C-02 Style 3	V <sub>DRM</sub> (Volts)	
2N6346A				MAC15A4		MAC15A4FP	200	
2N6347A	<i>MAC12D</i>	<i>MAC15D</i>	<i>MAC15SD</i>	MAC15A6	<i>MAC16D</i>	MAC15A6FP	400	
2N6348A	<i>MAC12M</i>	<i>MAC15M</i>	<i>MAC15SM</i>	MAC15A8	<i>MAC16M</i>	MAC15A8FP	600	
2N6349A	<i>MAC12N</i>	<i>MAC15N</i>	<i>MAC15SN</i>	MAC15A10	<i>MAC16N</i>	MAC15A10FP	800	
Maximum Electrical Characteristics								
120		150		120		150		I <sub>TSM</sub> (Amps)
				Min.	Max.			I <sub>GT</sub> @ 25°C (mA)
50		35		0.8	5.0	50	50	MT2(+) <i>G</i> (+)
75		35		0.8	5.0	50	50	MT2(+) <i>G</i> (-)
50		35		0.8	5.0	50	50	MT2(-) <i>G</i> (-)
75		—		—	—	75(1)	—	MT2(-) <i>G</i> (+)
				Min.	Max.			V <sub>GT</sub> @ 25°C (V)
2		1.5		0.45	1.5	2	1.5	MT2(+) <i>G</i> (+)
2.5		1.5		0.45	1.5	2	1.5	MT2(+) <i>G</i> (-)
2		1.5		0.45	1.5	2	1.5	MT2(-) <i>G</i> (-)
2.5		—		—	—	2.5(1)	—	MT2(-) <i>G</i> (+)
		Min.	Min.	Min.		Min.		DV/DT V/μsec
		250	250	25		500		
-40 to +125				-40 to +110		-40 to +125		T <sub>J</sub> Operating Range (°C)


 Indicates UL Recognized — File #E69369

Devices listed in bold, italic are Motorola preferred devices.

# TRIACs (continued)

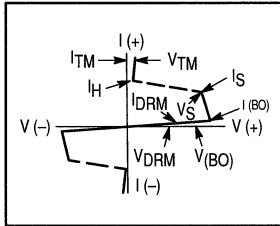
Table 2. TRIACs (continued)

V <sub>DRM</sub> (Volts)	On-State (RMS) Current					
	20 AMPS		25 AMPS		40 AMPS	
	T <sub>C</sub> = 75°C			T <sub>C</sub> = 80°C		T <sub>C</sub> = 75°C
						
	Isolated 			Isolated 		
	Case 221C-02 Style 3	Case 221A-04 TO-220AB Style 4		Case 221C-02 Style 3	Case 221A-04 TO-220AB Style 4	
200	MAC320A4FP	MAC320A4	MAC321-4	MAC223A4FP	<b>MAC223A4</b>	<b>MAC224A4</b>
400	MAC320A6FP	MAC320A6	MAC321-6	MAC223A6FP	<b>MAC223A6</b>	<b>MAC224A6</b>
600	MAC320A8FP	MAC320A8	MAC321-8	MAC223A8FP	<b>MAC223A8</b>	<b>MAC224A8</b>
800	MAC320A10FP	MAC320A10	MAC321-10	MAC223A10FP	<b>MAC223A10</b>	<b>MAC224A10</b>
Maximum Electrical Characteristics						
I <sub>TSM</sub> (Amps)	150		250		350	
I <sub>GT</sub> @ 25°C (mA)						
MT2(+) <sub>G</sub> (+)	50	100		50		
MT2(+) <sub>G</sub> (-)	50	100		50		
MT2(-) <sub>G</sub> (-)	50	100		50		
MT2(-) <sub>G</sub> (+)	75(1)	—		75(1)		
V <sub>GT</sub> @ 25°C (V)						
MT2(+) <sub>G</sub> (+)	2	2		2		
MT2(+) <sub>G</sub> (-)	2	2		2		
MT2(-) <sub>G</sub> (-)	2	2		2		
MT2(-) <sub>G</sub> (+)	2.5(1)	—		2.5(1)		
T <sub>J</sub> Operating Range (°C)	-40 to +125					

 Indicates UL Recognized — File #E69369

Devices listed in bold, italic are Motorola preferred devices.

# Thyristor Triggers



**Table 3. SIDACs**

High voltage trigger devices similar in operation to a Triac. Upon reaching the breaker voltage in either direction, the device switches to a low-voltage on-state.

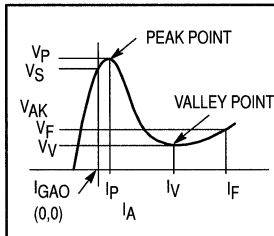
Device Type	I <sub>TSM</sub> Amps	V <sub>BO</sub> Volts	
		Min	Max

**Case 267-03/1**

<b>MKP3V110</b>	20	100	120
<b>MKP3V120</b>	20	110	130
<b>MKP3V130</b>	20	120	140

**Case 59-04/1**

<b>MKP1V120</b>	4	110	130
<b>MKP1V130</b>	4	120	140



**Table 4. Programmable Unijunction Transistor — PUT**

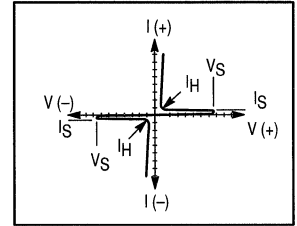
Similar to UJTs, except that  $I_V$ ,  $I_P$  and intrinsic standoff voltage are programmable (adjustable) by means of external voltage divider. This stabilizes circuit performance for variations in device parameters. General operating frequency range is from 0.01 Hz to 10 kHz, making them suitable for long-duration timer circuits.

Device Type	I <sub>P</sub>		I <sub>GAO</sub> @ 40 V nA Max	I <sub>V</sub>	
	R <sub>G</sub> = 10 kΩ	R <sub>G</sub> = 1 MΩ		R <sub>G</sub> = 10 kΩ	R <sub>G</sub> = 1 MΩ
	μA Max			μA Min	μA Max

**Plastic TO-92 (Case 29-04/16)**

<b>2N6027</b>	5	2	10	70	50
<b>2N6028</b>	1	0.15	10	25	25

Devices listed in bold, italic are Motorola preferred devices.



**Table 5. Silicon Bidirectional Switch (SBS)**

This versatile trigger device exhibits highly symmetrical bi-directional switching characteristics which can be modified by means of a gate lead. Requires a gate trigger current of only 250 μA for triggering.

Device Type	V <sub>S</sub> Volts		I <sub>S</sub> μA Max	I <sub>H</sub> mA Max
	Min	Max		

**Plastic TO-92/TO-226AA (Case 29-04/12)**

MBS4991	6	10	500	1.5
MBS4992	7.5	9	120	0.5
MBS4993	7.5	9	250	0.75

**Table 6. High Voltage Bidirectional TVS Devices Primary Protection**

Transient Voltage Suppression (TVS) devices are break-over-triggered crowbar protectors. Turn-off occurs when the surge current falls below the holding current value.

Device Type	I <sub>TSM</sub> Amps	V <sub>BR</sub> Volts (Min)	V <sub>BO</sub> Volts (Max)
-------------	-----------------------	-----------------------------	-----------------------------

**Case 416A-01**

<b>MMT10V275</b>	100	200	275
<b>MMT10V400</b>	100	265	400

**Thyristor Surge Suppressors—Secondary Protection**

**Package SO-8**

<b>MGSS150-1</b>	30 AMP, 150 mA I <sub>H</sub> , Programmable Bidirectional Surge Suppressor
------------------	---

**Package 8 Pin PDIP**

<b>MGSS150-2</b>	30 AMP, 150 mA I <sub>H</sub> , Programmable Bidirectional Surge Suppressor
------------------	---

- Telecom Line Card Protection
- Dual Line Protection in a Single Package
- 2 Package Choices
- Bidirectional Capability
- 30 AMP Surge
- 150 mA I<sub>H</sub>
- Low Gate Trigger Current

# Optoelectronic Devices

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## In Brief . . .

Motorola's families of optoelectronic components encompass red and infrared GaAs emitters and silicon detectors that are well matched for a variety of applications.

### Optoisolators

Motorola's "Global" 6-Pin Dual In-line Package (DIP) devices use infrared emitting diodes that are optically coupled to a wide selection of output (Transistor, Darlington, Triac, and Schmitt trigger) silicon detectors. These devices are guaranteed to provide at least 7500 volts of isolation between the input and output and are 100% VISO tested. The entire line of Motorola 6-pin DIP packages are recognized by all major safety regulatory agencies including UL and VDE. This extensive line of regulatory approvals attest to their suitability for use under the most stringent conditions. Motorola also offers a line of SOIC-8 small outline, surface mount devices that are UL approved and ideally suited for high density applications.

### POWER OPTO™ Isolators

The MOC2A60 series is the first member of the POWER OPTO™ Isolator family from Motorola. The MOC2A60 is a 2 Amp @ 40°C/600 Vac[pk]/Zero-Crossing/Optically Coupled Triac. This isolated AC output device is ruggedized to survive the harsh operating environments inherent in Industrial Controller applications. Additionally, the thermally optimized SIP package profile allows for high density stacking on 0.200" centers and can handle 2 Amps @ 40°C (Free-Air Rating) *without the need for heatsinks, thermal grease, etc.*

	<b>Page</b>
Optoisolators . . . . .	5.8-2
Safety Standard Approvals for 6-Pin	
Optoisolators . . . . .	5.8-2
Regulatory Approval Certification Index . . . . .	5.8-2
VDE Approved Optoisolators . . . . .	5.8-3
6-Pin Dual In-line Package . . . . .	5.8-6
Small Outline — Surface Mount . . . . .	5.8-9
POWER OPTO Isolators . . . . .	5.8-10









# Safety Regulatory Approvals for Motorola's "Global" Optoisolators

Motorola's entire line of 6-pin optoisolators are approved by all major safety regulatory agencies.

## Safety Standard Approvals for 6-Pin Optoisolators



GlobalOptoisolator™

								
	VDE	UL	CSA	SETI	SEMKO	DEMKO	NEMKO	BABT
MOCXXXX	• (1)	*	*	*	*	*	*	*
SOCXXXX	• (1)	*	*	*	*	*	*	*
4NXXXXXX	• (1)	*	*	*	*	*	*	*
H1XXXXXX	• (1)	*	*	*	*	*	*	*
MCXXXXXX	• (1)	*	*	*	*	*	*	*
TIXXXXXX	• (1)	*	*	*	*	*	*	*
CNXXXXXX	• (1)	*	*	*	*	*	*	*

\* = Approved

## Regulatory Approval Certification Index

Regulatory Agency	Certificate File Number
VDE(0883)	41853 (expired 12/31/91)
VDE(0884) <sup>(1)</sup>	62054 (replaces VDE0883)
UL (isolation)	E54915
UL (flammability)	E-8436
CSA	CA93952
FIMKO	41990
SEMKO	9313138
DEMKO	Approved per SEMKO
NEMKO	A99177
BABT	CR/0117
AUSTEL	03 887 0711

Note: Motorola's 8-pin surface mount optocouplers are approved by UL only and have a guaranteed isolation voltage of 3000 Vac(rms).

All Motorola 6-pin optocouplers are 100% tested for isolation voltage and are guaranteed to 7500 Vac(peak).

UL Flammability Rating = 94VO (File number E-8436) for all optocouplers.

**(1) VDE 0884 testing is an option; the suffix letter "V" must be added to the standard part number.**



# VDE Approved Optoisolators

VDE has approved Motorola's entire portfolio of 6-pin DIP optoisolators against their new components standard VDE 0884 which replaces VDE 0883. The VDE 0884 components standard requires additional electrical testing to a stringent isolation partial discharge test.

The VDE 0883 specification expired 12/31/91. Motorola optoisolators can now be ordered to comply with the VDE 0884 specification.

VDE approval is based on mechanical and electrical performance of the Motorola package, shown in Figure 3. This 6-Pin DIP package incorporates specially developed materials and assembly processes optimizing thermal and moisture stability while maintaining the high level of LED life and isolation voltage. All Motorola 6-pin DIP optoisolators are made in this package, and have these approvals.

## VDE 0884 Component Standard (replaces VDE 0883)

Electrical ratings in this standard are:

Input-to-Output Voltage, 1 second

$V_{PR1} = 1.6 V_{IDRM}$ , Partial Discharge < 5 picocoulombs,

$V_{PR1} = 1280 V(pk)$

Maximum operating peak voltage,  $V_{IDRM} = 800 V(pk)$

Isolation resistance:  $V_{LO} = 500 Vdc$ ,  $10^{11} \Omega$ ,  $T_A = 100^\circ C$ .

Note: The isolation partial discharge test  $V_{PR1}$ , is performed after the completion of the high voltage withstand (hipot) tests.

## VDE 0883 Component Standard (expired 12/31/91)

Electrical ratings in this standard were:

Isolation withstand voltages:

3750  $V_{RMS}$ , 1 min,  $T_A = 100^\circ C$

5300 Vdc, 1 min,  $T_A = 100^\circ C$

Isolation surge withstand voltage:

10 kV per IEC 65, 50 discharges

Isolation resistance:

$10^{11} \Omega$ , 500 Vdc,  $T_A = 100^\circ C$

NOTE: **VDE 0884/8.87 testing is an option**; the suffix letter "V" must be added to the standard part number. (See below.)

Standard thru hole — MOC3063V

0.4" wide spaced leadform — MOC3063TV (to satisfy 8 mm spacing requirement)

Standard-profile surface mount — MOC3063SV

Tape and Reel for surface mount — MOC3063S/SR2V

Optoisolators, a block diagram of which is shown in Figure 1, are devices which contain at least one emitter, which is optically coupled to a photo-detector through some sort of an insulating medium. This arrangement permits the passage of information from one circuit, which contains the emitter, to the other circuit containing the detector.

Because this information is passed optically across an insulating gap, the transfer is one-way; that is, the detector cannot affect the input circuit. This is important because the emitter may be driven by a low voltage circuit utilizing an MPU or logic gates, while the output photo-detector may be part of a high voltage dc or even an ac load circuit. The optical isolation prevents interaction or even damage to the input circuit to be caused by the relatively hostile output circuit.

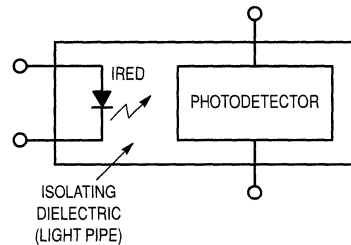


Figure 1. Block Diagram of Optoisolator

Various geometric designs have been used over the years for the internal light cavity between the emitter and detector. Motorola is the industry leader in isolation technology. All 6-pin optoisolators are guaranteed to meet or exceed 7500 Vac (pk) input-to-output isolation. See Figure 2.

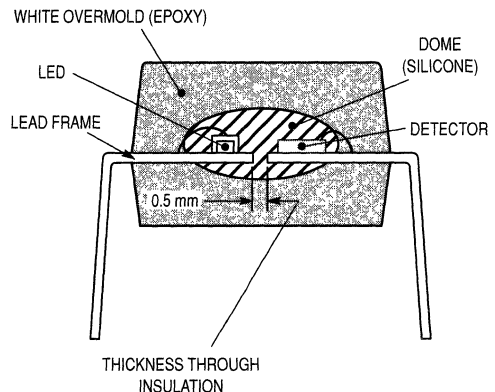


Figure 2. Geometric Design for Optoisolators

## VDE Approved Optoisolators (continued)

### Equipment Standards Compliance

With the approval of the Motorola package to these component standards, combined with its VDE approval ratings, a wide range of Equipment Standards are covered. The table below summarizes these Equipment Standard coverages.

Two levels of electrical interface, or insulation, are used: 1. Reinforced, or safe, insulation; 2. Basic insulation.

**Reinforced Insulation** (sometimes referred to as "safe" electrical isolation) is required in an optoisolator interfacing between a hazardous voltage circuit, like an ac line, and a **touchable safe extra low voltage (SELV)** circuit.

**Basic Insulation** is required in an optoisolator which interfaces between a hazardous voltage circuit and a **non-touchable, extra low voltage (ELV)** circuit.

The 6-pin DIP optoisolators are suitable for both levels of electrical interface. The smaller SOIC-8 optoisolators comply with basic Insulation standards only.

Mechanical ratings are shown in the table below.

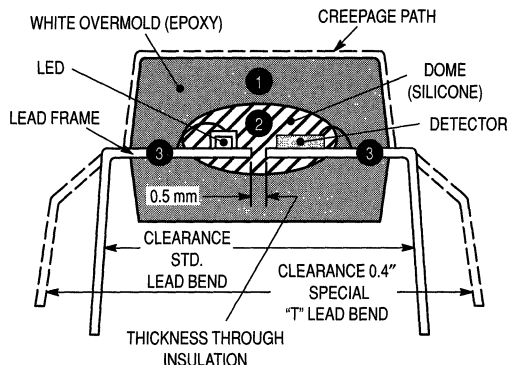


Figure 3. "DOME" Package

### Examples for Safety Applications for Motorola VDE Approved Optoisolators

Standard (2)		Equipment	Requirements for reinforced (double) or safe insulation for equipment with an operating voltage up to 250 Vrms (line voltage to ELV or SELV interfaces)				
VDE (5)	DIN IEC		Creepage	Clearance (1)	Isolation Barrier	Dielectric Strength	Isolation Resistance
			[mm]	[mm]	[mm]	[kV RMS]	[Ω]
0806	950	Office Machines	8.0	8.0	0.5	3.75	7 x 10 <sup>6</sup>
0805	950	Data Processing	8.0	8.0	—	3.75	7 x 10 <sup>6</sup>
0804	—	Telecommunication	8.0	8.0	—	2.5	2 x 10 <sup>6</sup>
0860	65	Electrical Household	6.0	6.0	0.4	3.0 (10)*	4 x 10 <sup>6</sup>
0113	204	Industrial Controls	8.0	8.0	—	2.5	1 x 10 <sup>6</sup>
0160	—	Power Installations with Electronic Equipment	8.0	8.0	—	2.7	1 x 10 <sup>6</sup>
0832	—	Traffic Light Controls	8.0	8.0	—	2.5	4 x 10 <sup>6</sup>
0883	—	Alarm Systems	8.0	8.0	—	2.5	2 x 10 <sup>6</sup>
0831	—	Electrical Signal System for Railroads	8.0	8.0	—	2.0	2 x 10 <sup>6</sup>
0110	—	General Std. for Electrical Equipment	8.0	8.0	—	2.0	—
0883	—	Optoisolator Component Standard (obsolete 12/31/91)	8.5	8.3 (10) (1)	0.5	3.75 (10)*	10 x 10 <sup>11</sup>
0884(4)	—	Optoisolator Component Standard (replaces VDE0883)	>7.5	>7.5	0.5	—	10 x 10 <sup>12</sup>
			VDE Rating for Motorola 6-pin DIP Optoisolators				

All Motorola 6-pin DIP Optoisolators meet or exceed the requirements of above listed VDE and DIN IEC Standards.

\* Impulse discharge withstand voltage.

(1) To satisfy 8.0 mm creepage path on a PC board Motorola offers a special lead bend of 0.4 inch on all 6-pin dual in-line optoisolators. Order by attaching "T" to the end of the Motorola part number.

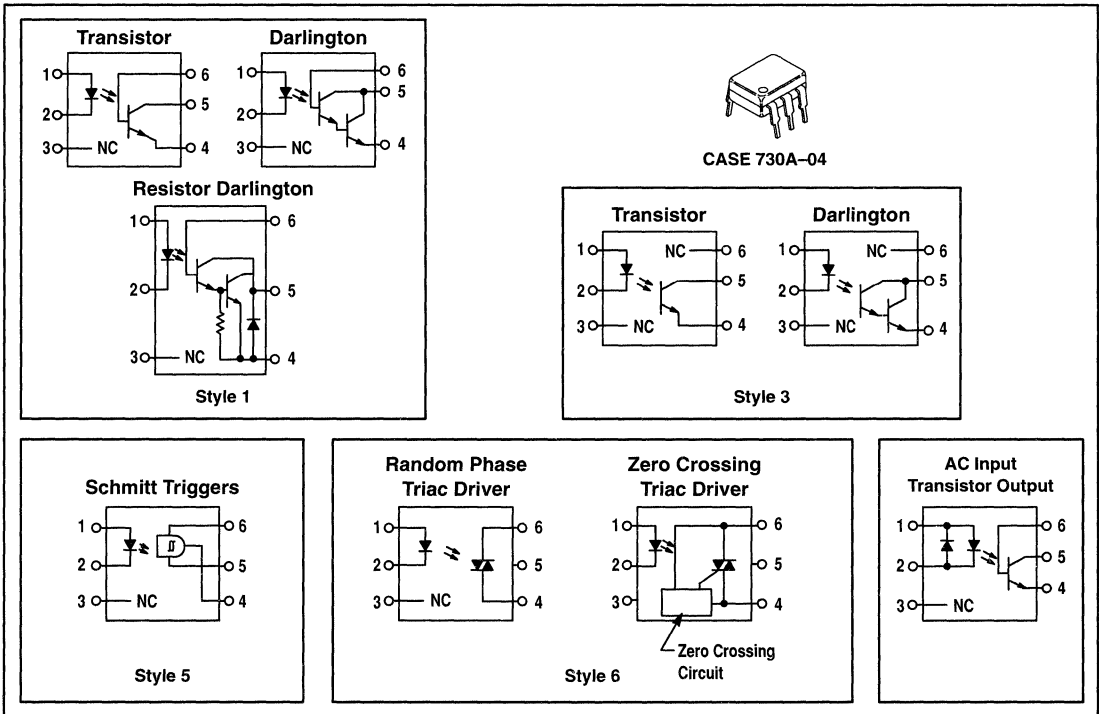
(2) VDE standards (translated into English language) and IEC standards can be ordered from the American National Standard Institute ANSI, 1430 Broadway, N.Y., N. Y. 10018, Sales Department, 212-642-4900.

(3) Creepage path distances are measured from lead to lead across the top, bottom and ends of the package body.

(4) VDE 0884 testing is an option; the suffix letter "V" must be added to the standard number.

(5) For more information regarding the use of VDE approved devices, refer to "VDE Circuit Board Layout Design Rules" in the Applications Information section.

# Optoisolators 6-Pin DIP Varieties and Lead Form Options



An optoisolator consists of a gallium arsenide infrared emitting diode, IRED, optically coupled to a monolithic silicon photodetector in a wide array of standard devices and encourages the use of special designs and selections for special applications. All Motorola optoisolators have  $V_{ISO}$  rating of 7500 Vac(pk), exceeding all other industry standard ratings.

Motorola offers global regulatory approvals, including UL, CSA, AUSTEL, NEMKO, BABT, SETI, SEMKO, and DEMKO. VDE(1) approved per standard 0884/8.87, with additional approvals to DIN IEC950 and IEC380/VDE 0806, IEC435/VDE 0805, IEC65/VDE 0860, VDE 110b, also covering all other standards with equal or less stringent requirements, including IEC204/VDE 0113, VDE 0160, VDE 0832, VDE 0833.

(1) VDE 0884/8.87 testing is an option; the suffix "V" must be added to the standard part number (see VDE Approved Optoisolators in Section 3).

**CASE 730A-04**

**S**  
Surface-mountable gull-wing option

**T**  
Wide-spaced (0.400) lead form option

**Optoisolator Lead Form Options:**

Most of Motorola's 6-pin, dual in-line optoisolators can be ordered in either a surface-mountable, gull-wing lead form or a wide-spaced 0.400" through-hole lead form, which is used to satisfy 8 mm PC board spacing requirements. **All available tape and reel and lead form options are available on designated prime devices. Please first reference "prime" device designation tables, prior to ordering!**

- Attach "S" to any Motorola 6-pin, dual in-line part number for surface-mountable, gull-wing lead form.
- Attach "T" to any Motorola 6-pin, dual in-line part number for wide-spaced 0.400" through-hole lead form.

**Tape and Reel Options:**

- Attach "SR2" suffix to any Motorola 6-pin, dual in-line part number for tape and reeled, surface-mountable, gull-wing lead form.

# 6-Pin Dual In-Line Package



CASE 730A-04

**Table 1. Transistor Output**

Pinout: 1–Anode, 2–Cathode, 3–N.C., 4–Emitter, 5–Collector, 6–Base (Style 1)

Device	Current Transfer Ratio (CTR)			V <sub>CE(sat)</sub>			t <sub>r</sub> /t <sub>f</sub> or t <sub>on</sub> <sup>*</sup> /t <sub>off</sub> <sup>*</sup> Typ					V <sub>(BR)CEO</sub> Volts Min	V <sub>F</sub>	
	%	I <sub>F</sub>	V <sub>CE</sub>	Volts	I <sub>F</sub>	I <sub>C</sub>	@	I <sub>C</sub>	V <sub>CC</sub>	R <sub>L</sub>	I <sub>F</sub>		Volts	I <sub>F</sub>
	Min	@	Volts	Max	@	mA	μs	mA	Volts	Ω	mA		Max	@
TIL111	8	16	0.4	0.4	16	2	5/5	2	10	100		30	1.4	16
4N27	10	10	10	0.5	50	2	1.2/1.3	10	10	100		30	1.5	10
4N28	10	10	10	0.5	50	2	1.2/1.3	10	10	100		30	1.5	10
4N38,A	20	20	1	1	20	4	1.6/2.2	10	10	100		80	1.5	10
<b>4N25</b>	20	10	10	0.5	50	2	1.2/1.3	10	10	100		30	1.5	10
4N26	20	10	10	0.5	50	2	1.2/1.3	10	10	100		30	1.5	10
MCT2	20	10	10	0.4	16	2	1.2/1.3		5	2k	15	30	1.5	20
MCT2E	20	10	10	0.4	16	2	1.2/1.3	2	10	100		30	1.5	20
<b>CNY17-1</b>	40–80	10	5	0.4	10	2.5	1.6/2.3 <sup>*</sup>		5	75	10	70	1.65	60
MCT271	45–90	10	10	0.4	16	2	4.9 <sup>*</sup> /4.5 <sup>*</sup>	2	5	100		30	1.5	20
MOC8100	50	1	5	0.5	1	0.1	3.8/5.6	2	10	100		30	1.4	1
<b>H11A1</b>	50	10	10	0.4	10	0.5	1.2/1.3	2	10	100		30	1.5	10
H11A550	50	10	10	0.4	20	2	5 <sup>*</sup> /5 <sup>*</sup>	2	10	100		30	1.5	10
TIL117	50	10	10	0.4	10	0.5	5/5	2	10	100		30	1.4	16
SL5501	45–250	10	0.4	0.4	20	2	20 <sup>*</sup> /50 <sup>*</sup>		5	1k	16	30	1.3	20
<b>CNY17-2</b>	63–125	10	5	0.4	10	2.5	1.6/2.3		5	75	10	70	1.65	60
MCT275	70–210	10	10	0.4	16	2	4.5 <sup>*</sup> /3.5 <sup>*</sup>	2	5	100		80	1.5	20
MCT272	75–150	10	10	0.4	16	2	6 <sup>*</sup> /5.5 <sup>*</sup>	2	5	100		30	1.5	20
<b>4N35</b>	100	10	10	0.3	10	0.5	3.2/4.7	2	10	100		30	1.5	10
4N36	100	10	10	0.3	10	0.5	3.2/4.7	2	10	100		30	1.5	10
4N37	100	10	10	0.3	10	0.5	3.2/4.7	2	10	100		30	1.5	10
<b>CNY17-3</b>	100–200	10	5	0.4	10	2.5	1.6/2.3		5	75	10	70	1.65	60
H11AV1	100–300	10	10	0.4	20	2	5 <sup>*</sup> /4 <sup>*</sup>	2	10	100		70	1.5	10
H11AV2	50	10	10	0.4	20	2	5 <sup>*</sup> /4 <sup>*</sup>	2	10	100		70	1.5	10

**Table 2. Transistor Output with No Base Connection**

Pinout: 1–Anode, 2–Cathode, 3–N.C., 4–Emitter, 5–Collector, 6–Base (Style 3)

<b>MOC8106</b>	50–150	10	10	0.4	5	0.5	3.2/4.7	2	10	100		70	1.5	10
<b>MOC8107</b>	100–300	10	10	0.4	5	0.5	3.2/4.7	2	10	100		70	1.5	10
<b>MOC8108</b>	250–600	10	10	0.4	5	0.5	3.2/4.7	2	10	100		70	1.5	10
MOC8111	20	10	10	0.4	10	0.5	3.2/4.7	2	10	100		30	1.5	10
<b>MOC8112</b>	50	10	10	0.4	10	0.5	3.2/4.7	2	10	100		30	1.5	10
MOC8113	100	10	10	0.4	10	0.5	3.2/4.7	2	10	100		30	1.5	10

**Table 3. AC Input – Transistor Output**

Pinout: 1–LED 1 Anode/LED 2 Cathode, 2–LED 1 Cathode/LED 2 Anode, 3–N.C., 4–Emitter, 5–Collector, 6–Base (Style 8)

Device	Current Transfer Ratio (CTR)			V <sub>CE(sat)</sub>			t <sub>r</sub> /t <sub>f</sub> or t <sub>on</sub> <sup>*</sup> /t <sub>off</sub> <sup>*</sup> Typ					V <sub>(BR)CEO</sub> Volts Min	V <sub>F</sub>	
	%	I <sub>F</sub>	V <sub>CE</sub>	Volts	I <sub>F</sub>	I <sub>C</sub>	@	I <sub>C</sub>	V <sub>CC</sub>	R <sub>L</sub>	I <sub>F</sub>		Volts	I <sub>F</sub>
	Min	@	Volts	Max	@	mA	μs	mA	Volts	Ω	mA		Max	@
<b>H11AA1</b>	20	±10	10	0.4	±10	0.5						30	1.5	±10
H11AA2	10	±10	10	0.4	±10	0.5						30	1.8	±10
H11AA3	50	±10	10	0.4	±10	0.5						30	1.5	±10
<b>H11AA4</b>	100	±10	10	0.4	±10	0.5						30	1.5	±10

Devices listed in bold, italic are Motorola preferred devices.

## 6-Pin Dual In-Line Package (continued)



CASE 730A-04

**Table 4. Darlington Output**

Pinout: 1–Anode, 2–Cathode, 3–N.C., 4–Emitter, 5–Collector, 6–Base (Style 1)

Device	Current Transfer Ratio (CTR)			$V_{CE(sat)}$			$t_r/t_f$ or $t_{on^*}/t_{off^*}$ Typ					$V_{(BR)CEO}$ Volts Min	$V_F$	
	% Min	@ $I_F$ mA	$V_{CE}$ Volts	Volts Max	@ $I_F$ mA	$I_C$ mA	$\mu s$	@ $I_C$ mA	$V_{CC}$ Volts	$R_L$ $\Omega$	$I_F$ mA		Volts Max	@ $I_F$ mA
4N31	50	10	10	1.2	8	2	0.6/17	50	10		200	30	1.5	10
4N29,A	100	10	10	1	8	2	0.6/17	50	10		200	30	1.5	10
4N30	100	10	10	1	8	2	0.6/17	50	10		200	30	1.5	10
MCA231	200	1	1	1.2	10	50	80	10	10	100		30	1.5	20
TIL113	300	10	1.0	1	50	125	300	125	15	100		30	1.5	10
<b>4N32</b>	500	10	10	1	8	2	0.6/45	50	10		200	30	1.5	10
4N33	500	10	10	1	8	2	0.6/45	50	10		200	30	1.5	10
<b>H11B1</b>	500	1	5	1	1	1	1/2	10	10	100		25	1.5	10
MOC8080	500	10	5	1	1	1	1/2	10	10	100	5	55	1.5	10

**Table 5. Darlington Output with No Base Connection**

Pinout: 1–Anode, 2–Cathode, 3–N.C., 4–Emitter, 5–Collector, 6–N.C. (Style 3)

MOC119	300	10	2	1	10	10	1/2	2.5	10	100		30	1.5	10
<b>MOC8030</b>	300	10	1.5				1/2		50	100	10	80	2	10
MOC8020	500	10	5				1/2		50	100	10	50	2	10
<b>MOC8050</b>	500	10	1.5				1/2		50	100	10	80	2	10
MOC8021	1000	10	5				1/2		50	100	10	50	2	10

**Table 6. Resistor Darlington Output**

Pinout: 1–Anode, 2–Cathode, 3–N.C., 4–Emitter, 5–Collector, 6–Base (Style 1)

<b>H11G1</b>	1000	10	1	1	1	1	5/100		5	100	10	100	1.5	10
H11G2	1000	10	1	1	1	1	5/100		5	100	10	80	1.5	10
H11G3	200	1	5	1.2	50	20	5/100		5	100	10	55	1.5	10

**Table 7. High Voltage Transistor Output**

Pinout: 1–Anode, 2–Cathode, 3–N.C., 4–Emitter, 5–Collector, 6–Base (Style 1)

<b>MOC8204</b>	20	10	10	0.4	10	0.5	5/5	2	10	100		400	1.5	10
<b>H11D1</b>	20	10	10	0.4	10	0.5	5/5	2	10	100		300	1.5	10
H11D2	20	10	10	0.4	10	0.5	5/5	2	10	100		300	1.5	10

Devices listed in bold, italic are Motorola preferred devices.

## 6-Pin Dual In-Line Package (continued)



CASE 730A-04

**Table 8. Triac Driver Output**

Pinout: 1–Anode, 2–Cathode, 3–N.C., 4–Main Terminal, 5–Substrate, 6–Main Terminal (Style 6)

Device	Peak Blocking Voltage Voltage Min	LED Trigger Current– $I_{FT}$ ( $V_{TM} = 3\text{ V}$ ) mA Max	Zero Crossing Inhibit Voltage (at rated $I_{FT}$ ) Volts Max	Operating Voltage Vac	$dv/dt$ $V/\mu s$ Typ
MOC3010	250	15	—	125	10
MOC3011	250	10	—	125	10
MOC3012	250	5	—	125	10
MOC3021	400	15	—	125/280	10
<b>MOC3022</b>	400	10	—	125/280	10
<b>MOC3023</b>	400	5	—	125/280	10
MOC3051	600	15	—	125/280	2000
<b>MOC3052</b>	600	10	—	125/280	2000
MOC3031	250	15	20	125	2000
MOC3032	250	10	20	125	2000
MOC3033	250	5	20	125	2000
MOC3041	400	15	20	125/280	2000
MOC3042	400	10	20	125/280	2000
<b>MOC3043</b>	400	5	20	125/280	2000
MOC3061	600	15	20	125/280	1500
MOC3062	600	10	20	125/280	1500
<b>MOC3063</b>	600	5	20	125/280	1500
MOC3162	600	10	15	125/280	1000
<b>MOC3163</b>	600	5	15	125/280	1000
MOC3081	800	15	20	125/280/320	1500
MOC3082	800	10	20	125/280/320	1500
<b>MOC3083</b>	800	5	20	125/280/320	1500

**Table 9. Schmitt Trigger Output**

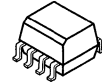
Pinout: 1–Anode, 2–Cathode, 3–N.C., 4–Output, 5–Ground, 6– $V_{CC}$  (Style 5)

Device	Threshold Current On mA Max	Threshold Current Off mA Min	$I_{F(off)}/I_{F(on)}$		$V_{CC}$		$t_r, t_f$ $\mu s$ Typ
			Min	Max	Min	Max	
<b>H11L1</b>	1.6	0.3	0.5	0.9	3	15	0.1
H11L2	10	0.3	0.5	0.9	3	15	0.1
MOC5007	1.6	0.3	0.5	0.9	3	15	0.1
MOC5008	4	0.3	0.5	0.9	3	15	0.1
MOC5009	10	0.3	0.5	0.9	3	15	0.1

Devices listed in bold, italic are Motorola preferred devices.

# Small Outline — Surface Mount

CASE 846-01  
SO-8 DEVICES



**Table 10. Transistor Output**

Pinout: 1—Anode, 2—Cathode, 3—N.C., 4—N.C., 5—Emitter, 6—Collector, 7—Base, 8—N.C. (Style 1)

Device	Marking	Current Transfer Ratio (CTR)			VCE(sat)			tr/τf Typ				VF		
		% Min	@ IF mA	VCE Volts	Volts Max	@ IF mA	IC mA	μs @ IC mA	VCC Volts	RL Ω	V(BR)CEO Volts Min	Volts Max @ IF mA		
<b>MOC205,R2</b>	205	40–80	10	10	0.4	10	2	1.6	2	10	100	70	1.5	10
<b>MOC206,R2</b>	206	63–125	10	10	0.4	10	2	1.6	2	10	100	70	1.5	10
<b>MOC207,R2</b>	207	100–200	10	10	0.4	10	2	1.6	2	10	100	70	1.5	10
<b>MOC211,R2</b>	211	20	10	10	0.4	10	2	3.2	2	10	100	30	1.5	10
<b>MOC212,R2</b>	212	50	10	10	0.4	10	2	3.2	2	10	100	30	1.5	10
<b>MOC213,R2</b>	213	100	10	10	0.4	10	2	3.2	2	10	100	30	1.5	10
<b>MOC215,R2</b>	215	20	1	5	0.4	1	0.1	3.2	2	10	100	30	1.3	1
<b>MOC216,R2</b>	216	50	1	5	0.4	1	0.1	3.2	2	10	100	30	1.3	1
<b>MOC217,R2</b>	217	100	1	5	0.4	1	0.1	3.2	2	10	100	30	1.3	1

**Table 11. Darlington Output**

Pinout: 1—Anode, 2—Cathode, 3—N.C., 4—N.C., 5—Emitter, 6—Collector, 7—Base, 8—N.C. (Style 1)

<b>MOC223,R2</b>	223	500	1	5	1	1	0.5	2	5	10	100	30	1.3	1
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All devices are shipped in tape and reel format. (See Tape and Reel Specifications Section for more information.)

**Table 12. AC Input – Transistor Output (Single Channel) (Style 2)**

<b>MOC256,R2</b>	256	20	±10	10	0.4	±10	0.5					30	1.5	±10
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**Table 13. Transistor Output (Dual Channel) (Style 3)**

<b>MOC207,R2</b>	D207	100–200	10	10	0.4	10	2	1.6	2	10	100	70	1.5	10
<b>MOC208,R2</b>	D208	45–125	10	10	0.4	10	2	1.6	2	10	100	70	1.5	10
<b>MOC211,R2</b>	D211	20	10	10	0.4	10	2	3.2	2	10	100	30	1.5	10
<b>MOC213,R2</b>	D213	100	10	10	0.4	10	2	3.2	2	10	100	70	1.5	10
<b>MOC217,R2</b>	D217	100	1	5	0.4	1	0.1	3.2	2	10	100	30	1.5	1

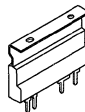
**Table 14. Darlington Output (Dual Channel) (Style 3)**

<b>MOC223,R2</b>	D223	500	1	5	1	1	0.5	2	5	10	100	30	1.3	1
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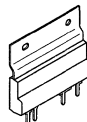
R2 devices are shipped in tape and reel format. (See Tape and Reel Specifications Section for more information.)

Devices listed in bold, italic are Motorola preferred devices.

# POWER OPTO™ Isolators



CASE 417-02  
PLASTIC PACKAGE



CASE 417A-02  
PLASTIC PACKAGE



CASE 417B-01  
PLASTIC PACKAGE

**Table 15. POWER OPTO Isolator 2 Amp Zero-Cross or Random Phase Triac Outputs**  
Pinout: (1,4,5,6,8 No Pin), 2 – LED Cathode, 3– LED Anode, 7–Main Terminal, 9–Main Terminal

Device	Peak Blocking Voltage (Volts) Min	Led Trigger Current If T ( $V_{TM} = 2 V$ ) mA Max	On State Voltage $V_{TM}$ (Rated $I_{FT}$ $I_{TM} = 2 A$ ) (Volts) Max	Zero Crossing Inhibit Voltage ( $I_F = \text{Rated } I_{FT}$ ) (Volts) Max	Operating Voltage Vac Pk (Volts)	dv/dt (static) $v/\mu s$ ( $V_{IN} = 200 V$ ) ( $V/\mu s$ ) Min
<b><i>MOC2A60-5</i></b>	600	5	1.3	10	125/220	400
MOC2A60-10	600	10	1.3	10	125/220	400
<b><i>MOC2R60-10</i></b>	600	10	1.3	N/A	125/220	400
MOC2R60-15	600	15	1.3	N/A	125/220	400

NOTE: Heat Tab options 417A-02 and 417B-01 are only available on boldface devices.

All devices are shipped in rails.

No suffix = Case 417-02/Style 2 (Standard Heat Tab),

"F" suffix = Case 417-02/Style 1 (Flush Mount Heat Tab)

"C" suffix = Case 417B-01/Style 1 (Cut Tab)

Devices listed in bold, italic are Motorola preferred devices.



# Sensors

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## In Brief . . .

Motorola's Sensor Products Division features three SENSEON™ families of acceleration, chemical (gas) and pressure sensor products. These sensors combine silicon micromachining with semiconductor manufacturing technology and processes for highly accurate, reliable, repeatable sensor products.

### Acceleration Sensors

The acceleration sensor portfolio includes the MMAS40G (16-pin DIP) and XMMAS40GWB (6-pin wingback) sensors. This family of sensors integrates the silicon micromachined g-cell sensing element with a control chip packaged in a rugged, plastic package for maximum versatility and functionality.

*Target applications: Automotive systems*

### Chemical Sensors

The newest member of the SENSEON sensor family is the MGS1100 carbon monoxide (CO) gas sensor introduced to the general market in October 1996. The MGS1100 represents the first mass produced, silicon micromachined sensor for carbon monoxide gas detection. Based on a technology licensed from MicroSens, (Neuchatel, Switzerland) these sensors feature an embedded heater layer that raises the temperature of the metal-oxide film to be sensitive to the target gas. Available in production quantities second quarter 1997, this line will continue to add new device enhancements and devices, including the MGS1200 methane sensor, in third quarter 1997 along with a new smoke detection product.

*Target applications: Industrial, commercial and consumer environmental detection products and systems.*

### Pressure Sensors

Combining integrated circuit technology with advanced pressure sensor architecture, this diverse family of pressure sensing products offers performance, reliability and design adaptability in a single monolithic device. The versatile MPX-series of pressure transducers are available in a number of versions:

- Fully signal conditioned for high-level output;
- High Impedance, temperature compensated and calibrated, for low current designs;
- Temperature compensated and calibrated, for simplified circuits
- Uncompensated for unlimited adaptability and;
- Packaging options for surface mount and piston fit applications

In addition, this series of sensors provides electrical, mechanical and media tolerant design-in options that uniquely fit the varying requirements of the system designer.

*Target applications: Automotive, industrial controls, biomedical and consumer products and systems.*

	<b>Page</b>
Introduction . . . . .	5.9-2
The Basic Structure . . . . .	5.9-2
Motorola's Patented X-ducer . . . . .	5.9-2
Linearity . . . . .	5.9-3
Operation . . . . .	5.9-3
Typical Electrical Characteristic Curves . . . . .	5.9-4
Unibody Cross-sectional Drawings . . . . .	5.9-5
Pressure Side Identification . . . . .	5.9-6
Selector Guide . . . . .	5.9-7
Reference Table . . . . .	5.9-13
Packaging Options . . . . .	5.9-14

# Pressure Sensors

## Introduction

Motorola pressure sensors combine advanced piezoresistive sensor architecture with integrated circuit technology to offer a wide range of pressure sensing devices for automotive, biomedical, consumer and industrial applications. Selection versatility includes choice of:

### Pressure Ranges in PSI

0 to 1.45, 0 to 6, 0 to 7.3, 0 to 14.5, 0 to 29, 0 to 75, 0 to 100, 0 to 150

### Sensing Options

Uncompensated, Temperature Compensated/Calibrated, High Impedance, and Signal Conditioned (with on-chip amplifiers)

### Application Measurements

Absolute, Differential, Gauge

### Package Options

Basic Element, Ported Elements for specific measurements

## The Basic Structure

The Motorola pressure sensor is designed utilizing a monolithic silicon piezoresistor, which generates a changing output voltage with variations in applied pressure. The resistive element, which constitutes a strain gauge, is ion implanted on a thin silicon diaphragm.

Applying pressure to the diaphragm results in a resistance change in the strain gauge, which in turn causes a change in the output voltage in direct proportion to the applied pressure. The strain gauge is an integral part of the silicon diaphragm, hence there are no temperature effects due to differences in thermal expansion of the strain gauge and the diaphragm. The output parameters of the strain gauge itself are temperature dependent, however, requiring that the device be compensated if used over an extensive temperature range. Simple resistor networks can be used for narrow temperature ranges, i.e., 0°C to 85°C. For temperature ranges from -40°C to +125°C, more extensive compensation networks are necessary.

## Motorola's Patented X-ducer™

Excitation current is passed longitudinally through the resistor (taps 1 and 3), and the pressure that stresses the diaphragm is applied at a right angle to the current flow. The stress establishes a transverse electric field in the resistor that is sensed as voltage at taps 2 and 4, which are located at the midpoint of the resistor. The single-element transverse voltage strain gauge can be viewed as the mechanical analog of a Hall effect device.

Using a single element eliminates the need to closely match the four stress and temperature sensitive resistors that form a Wheatstone bridge design. At the same time, it greatly simplifies the additional circuitry necessary to accomplish calibration and temperature compensation. The offset does not depend on matched resistors but instead on how well the transverse voltage taps are aligned. This alignment is accomplished in a single photolithographic step, making it easy to control, and is only a positive voltage, simplifying schemes to zero the offset.

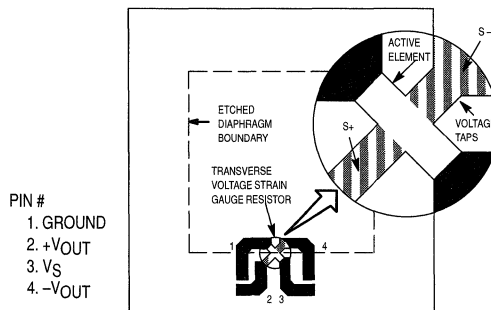


Figure 1. Basic Uncompensated Sensor Element — Top View

# Linearity

Linearity refers to how well a transducer's output follows the equation:  $V_{out} = V_{off} + \text{sensitivity} \times P$  over the operating pressure range. There are two basic methods for calculating nonlinearity: (1) end point straight line fit (see Figure 2) or (2) a least squares best line fit. While a least squares fit gives the "best case" linearity error (lower numerical value), the calculations required are burdensome.

Conversely, an end point fit will give the "worst case" error (often more desirable in error budget calculations) and the calculations are more straightforward for the user. Motorola's specified pressure sensor linearities are based on the end point straight line method measured at the midrange pressure.

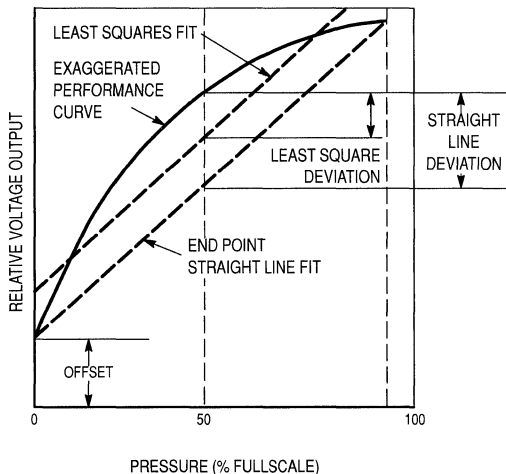


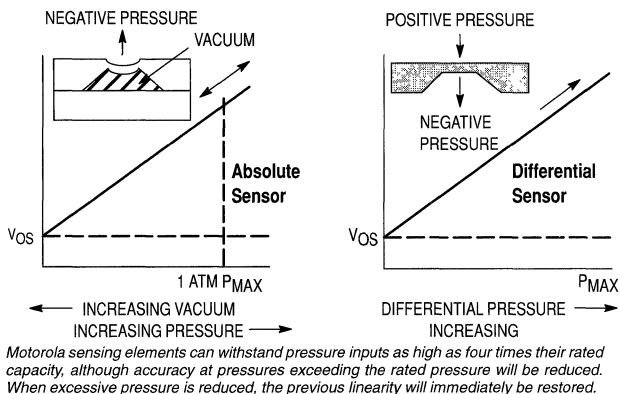
Figure 2. Linearity Specification Comparison

# Operation

Motorola pressure sensors support three types of pressure measurements: Absolute Pressure, Differential Pressure and Gauge Pressure.

**Absolute Pressure Sensors** measure an external pressure relative to a zero-pressure reference (vacuum) sealed inside the reference chamber of the die during manufacture. This corresponds to a deflection of the diaphragm equal to approximately 14.5 psi (one atmosphere), generating a quiescent full-scale output for the MPX100A (14.5 psi) sensor, and a half-scale output for the MPX200A (29 psi) device. Measurement of external pressure is accomplished by applying a relative negative pressure to the "Pressure" side of the sensor.

**Differential Pressure Sensors** measure the difference between pressures applied simultaneously to opposite sides of the diaphragm. A positive pressure applied to the "Pressure" side generates the same (positive) output as an equal negative pressure applied to the "Vacuum" side.



Motorola sensing elements can withstand pressure inputs as high as four times their rated capacity, although accuracy at pressures exceeding the rated pressure will be reduced. When excessive pressure is reduced, the previous linearity will immediately be restored.

Figure 3. Pressure Measurements

**Gauge Pressure** readings are a special case of differential measurements in which the pressure applied to the "Pressure" side is measured against the ambient atmospheric pressure applied to the "Vacuum" side through the vent hole in the chip of the differential pressure sensor elements.

# Typical Electrical Characteristic Curves

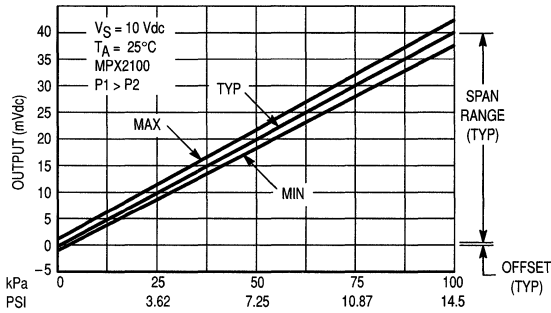


Figure 4. Output versus Pressure Differential

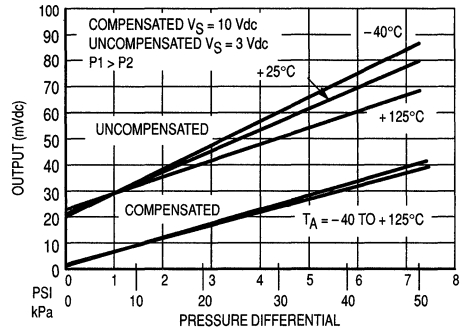


Figure 5. Typical—Output Voltage versus Pressure and Temperature for Compensated and Uncompensated Devices

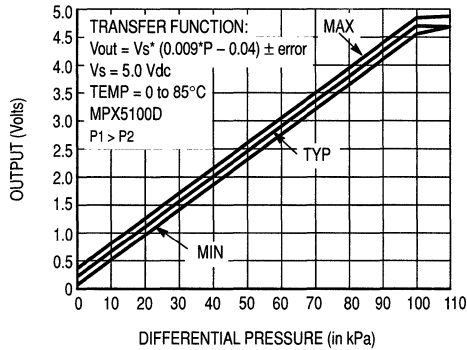
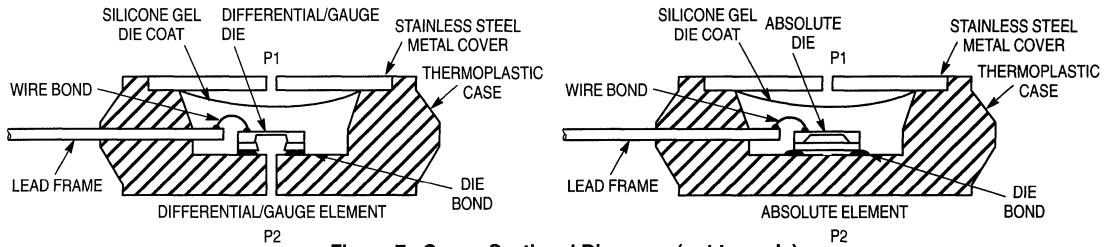


Figure 6. Signal Conditioned MPX5100

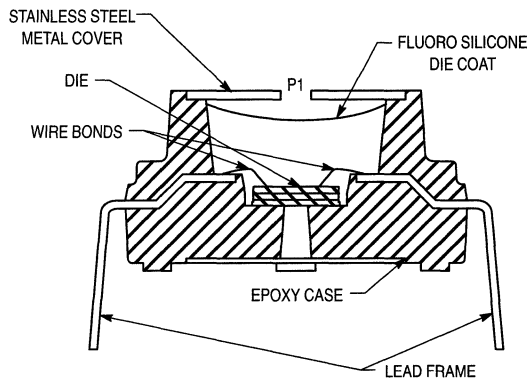
# Unibody Cross-sectional Drawings



**Figure 7. Cross-Sectional Diagrams (not to scale)**

Figure 7 illustrates the absolute sensing configuration (right) and the differential or gauge configuration in the basic chip carrier (Case 344). A silicone gel isolates the die surface and wire bonds from harsh environments, while allowing the pressure signal to be transmitted to the silicon diaphragm.

The MPX series pressure sensor operating characteristics and internal reliability and qualification tests are based on use of dry air as the pressure media. Media other than dry air may have adverse effects on sensor performance and long term stability. Contact the factory for information regarding media compatibility in your application.



**Figure 8. Cross-Sectional Diagram (not to scale)**

Figure 8 illustrates the differential/gauge die in the basic chip carrier (Case 434). A silicone gel isolates the die surface and wirebonds from the environment, while

allowing the pressure signal to be transmitted to the silicon diaphragm.

# Pressure Side Identification

Motorola designates the two sides of the pressure sensor as the Pressure (P1) side and the Vacuum (P2) side. The Pressure (P1) side is the side containing the silicon gel which protects the die. The differential or gauge sensor is designed to operate with positive differential pressure applied,  $P1 > P2$ .

The absolute sensor is designed for vacuum applied to P1 side.

The Pressure (P1) side may be identified by using the table below.

**Table 1. Pressure (P1) / Vacuum (P2) Side Identification**

Part Number	Case Type 4 PIN	Positive Pressure Side Identifier
MPXxxxxA MPXxxxxD	344-15	Stainless Steel Cap
MPXxxxxDP	352-03	Side with Part Marking
MPXxxxxAP MPXxxxxGP	350-05	Side with Port Attached
MPXxxxxGVP	350-06	Stainless Steel Cap
MPXxxxxAS MPXxxxxGS	371-08	Side with Port Attached
MPXxxxxGVS	371-07	Stainless Steel Cap
MPXxxxxASX MPXxxxxGSX	371C-03	Side with Port Attached
MPXxxxxGVSX	371D-03	Stainless Steel Cap
Part Number	Case Type 6 PIN	Positive Pressure Side Identifier
MPXxxxxA MPXxxxxD	867-08	Stainless Steel Cap
MPXxxxxDP	867C-05	Side with Part Marking
MPXxxxxAP MPXxxxxGP	867B-04	Side with Port Attached
MPXxxxxGVP	867D-04	Stainless Steel Cap
MPXxxxxAS MPXxxxxGS	867E-03	Side with Port Attached
MPXxxxxGVS	867A-04	Stainless Steel Cap
MPXxxxxASX MPXxxxxGSX	867F-03	Side with Port Attached
MPXxxxxGVSX	867G-03	Stainless Steel Cap
MPXxxxxGVW	867H-03	Stainless Steel Cap

## PRESSURE SENSOR PRODUCTS

**Table 2. Uncompensated**

Device Series	Max Pressure Rating		Over Pressure (kPa)	Offset mV (Typ)	Full Scale Span mV (Typ)	Sensitivity (mV/kPa)	Linearity % of FSS <sup>(1)</sup>	
	psi	kPa					(Min)	(Max)
MPX10D	1.45	10	75	20	35	3.5	-1.0	1.0
MPX50D	7.3	50	200	20	60	1.2	-0.25	0.25
MPX100D,A	14.5	100	200	20	60	0.6	-0.25	0.25
MPX200D,A	29	200	400	20	60	0.3	-0.25	0.25
MPX700A	100	700	2800	20	60	0.086	-1.0	1.0
MPX700D	100	700	2800	20	60	0.086	-0.50	0.50

**Table 3. Compensated and Calibrated (On-Chip)**

MPX2010D	1.45	10	75	±1.0	25	2.5	-1.0	1.0
MPX2050D	7.3	50	200	±1.0	40	0.8	-0.25	0.25
MPX2052D	7.3	50	200	±1.0	40	0.8	-0.55	0.25
MPX2100A	14.5	100	400	±2.0	40	0.4	-1.0	1.0
MPX2200A	29	200	400	±1.0	40	0.2	-1.0	1.0
MPX2700A	100	700	2800	±2.0	40	0.057	-1.0	1.0
MPX2700D	100	700	2800	±1.0	40	0.057	-0.5	0.5

**Table 4. High Impedance (On-Chip)**

MPX7050D	7.3	50	200	±1.0	40	0.8	-0.25	0.25
MPX7100A	14.5	100	400	±2.0	40	0.4	-1.0	1.0
MPX7100D	14.5	100	400	±1.0	40	0.4	-0.25	0.25
MPX7200A	29	200	400	±2.0	40	0.2	-1.0	1.0
MPX7200D	29	200	400	±1.0	40	0.2	-0.25	0.25

**Table 5. Compensated and Calibrated (On-Chip) Medical Grade**

Device Series	Max Pressure Rating		Supply Voltage (Vdc)	Offset mV (Max)	Sensitivity (µV/V/mmHg)	Output Impedance Ohms (Max)	Linearity % of FSS <sup>(1)</sup>	
	psi	kPa					(Min)	(Max)
MPX2300DT1	5.8	40	6.0	0.75	5.0	330	-2.0	2.0

<sup>(1)</sup>Based on end point straight line fit method. Best fit straight line linearity error is approximately 1/2 of listed value.

**Table 6. Signal Conditioned (On-Chip)**

Device Series	Max Pressure Rating		Over Pressure (kPa)	Full Scale Span V (Typ)	Sensitivity (mV/kPa)	Accuracy (0–85°C) % of V <sub>FSS</sub>
	psi	kPa				
MPX4100A	15.2	105	400	4.59	54	±1.8
MPX4101A	14.7	102	400	4.59	54	±1.8
MPX4115A	16.6	115	400	4.59	45.9	±1.5
MPX4250A	36.2	250	400	4.69	20	±1.5
MPX5010D	1.45	10	75	4.5	450	±5.0
MPX5050D	7.3	50	200	4.5	90	±2.5
MPX5100A	16.6	115	400	4.5	45	±2.5
MPX5100D	14.5	100	400	4.5	45	±2.5
MPX5500D	72.5	500	2000	4.5	9.0	±2.5
MPX5700D	100	700	2800	4.5	6.0	±2.5
MPX5999D	150	1000	4000	4.7	5.0	±2.5

***Bold italic*** indicates product introduced in the last 12 months.

**Table 7. MPX10/50/100/200/700 Series (Uncompensated)**

Device Type	Measurement/Porting Options	Package Options	Pressure Range				
			0 to 1.45 PSI (0 to 10 kPa)	0 to 7.3 PSI (0 to 50 kPa)	0 to 14.5 PSI (0 to 100 kPa)	0 to 29 PSI (0 to 200 kPa)	0 to 100 PSI (0 to 700 kPa)
4-Pin Basic Elements	Absolute	Case 344-15	—	—	MPX100A	MPX200A	MPX700A
	Differential	Case 344-15	MPX10D	MPX50D	MPX100D	MPX200D	MPX700D
Ported Elements	Absolute Port	Case 350-05	—	—	MPX100AP	MPX200AP	MPX700AP
	Absolute Stovepipe	Case 371-07	—	—	MPX100AS	MPX200AS	—
	Absolute Axial	Case 371C-03	—	—	MPX100ASX	—	MPX700ASX
	Differential Port	Case 352-03	MPX10DP	MPX50DP	MPX100DP	MPX200DP	MPX700DP
	Gauge	Case 350-05	MPX10GP	MPX50GP	MPX100GP	MPX200GP	MPX700GP
	Gauge Vacuum	Case 350-06	MPX10GVP	MPX50GVP	MPX100GVP	MPX200GVP	—
	Gauge Stovepipe	Case 371-07	MPX10GS	MPX50GS	MPX100GS	MPX200GS	—
	Gauge Vacuum Stovepipe	Case 371-08	—	—	MPX100GVS	—	—
	Gauge Axial	Case 371C-03	MPX10GSX	MPX50GSX	MPX100GSX	MPX200GSX	MPX700GSX
	Gauge Vacuum Axial	Case 371D-03	—	MPX50GVSX	MPX100GVSX	—	—

**Table 8. MPX900 Series (Uncompensated) (Water vapor and soapy water vapor tolerant)**

Device Type	Measurement Options	Package Options	Pressure Range
			0 to 0.87 PSI (0 to 6 kPa)
6-Pin Basic Element	Differential	Case 867-07	MPX906D
Ported Element	Gauge Axial	Case 867H-03	MPX906GVW

Device Series	Max Pressure Rating		Over Pressure (kPa)	Offset mV (Typ)	Full Scale Span mV (Typ)	Sensitivity (mV/kPa)	Linearity % of FSS <sup>(1)</sup>	
	psi	kPa					(Min)	(Max)
MPX906D	0.87	6	100	20	20	3.3	-0.50	2.0

**Table 9. MPX2000 Series (Temperature Compensated and Calibrated On-Chip)**

Device Type	Measurement Options	Package Options	Pressure Range				
			0 to 1.45 PSI (0 to 10 kPa)	0 to 7.3 PSI (0 to 50 kPa)	0 to 14.5 PSI (0 to 100 kPa)	0 to 29 PSI (0 to 200 kPa)	0 to 100 PSI (0 to 700 kPa)
4-Pin Basic Elements	Absolute	Case 344-15	—	—	MPX2100A	MPX2200A	MPX2700A
	Differential	Case 344-15	MPX2010D	MPX2050D	MPX2100D	MPX2200D	MPX2700D
Ported Elements	Absolute Port	Case 350-05	—	—	MPX2100AP	MPX2200AP	MPX2700AP
	Absolute Stovepipe	Case 371-07	—	—	MPX2100AS	MPX2200AS	MPX2700AS
	Absolute Axial	Case 371C-03	—	—	MPX2100ASX	MPX2200ASX	MPX2700ASX
	Differential Port	Case 352-03	MPX2010DP	MPX2050DP	MPX2100DP	MPX2200DP	MPX2700DP
	Gauge	Case 350-05	MPX2010GP	MPX2050GP	MPX2100GP	MPX2200GP	MPX2700GP
	Gauge Vacuum	Case 350-06	MPX2010GVP	MPX2050GVP	MPX2100GVP	—	—
	Gauge Stovepipe	Case 371-07	MPX2010GS	—	MPX2100GS	—	—
	Gauge Vacuum Stovepipe	Case 371-08	MPX2010GVS	—	MPX2100GVS	—	—
	Gauge Axial	Case 371C-03	MPX2010GSX	MPX2050GSX	MPX2100GSX	MPX2200GSX	MPX2700GSX
	Gauge Vacuum Axial	Case 371D-03	—	—	MPX2100GVSX	—	—



**Table 10. MPX4000 Series (Signal Conditioned On-Chip)**

Device Type	Measurement Options	Package Options	Pressure Range			
			3 to 15 PSI (20 to 105 kPa)	2.3 to 14.7 PSI (15 to 102 kPa)	2.3 to 16.6 PSI (15 to 115 kPa)	3 to 36.2 PSI (20 to 250 kPa)
6-Pin						
Basic Element	Absolute	Case 867-08	MPX4100A	MPX4101A	MPX4115A	MPX4250A
Ported Element	Absolute Port	Case 867B-04	MPX4100AP	MPX4101AP	MPX4115AP	MPX4250AP
	Absolute Stovepipe	Case 867E-03	MPX4100AS	MPX4101AS	MPX4115AS	---
	Absolute Axial	Case 867F-03	MPX4100ASX	MPX4101ASX	MPX4115ASX	MPX4250ASX

**Table 11. MPX5000 Series (Signal Conditioned On-Chip)**

Device Type	Measurement Options	Package Options	Pressure Range						
			0 to 1.45 PSI (0 to 10 kPa)	0 to 7.3 PSI (0 to 50 kPa)	0 to 14.5 PSI (0 to 100 kPa)	2.3 to 16.6 PSI (15 to 115 kPa)	0 to 75 PSI (0 to 500 kPa)	0 to 100 PSI (0 to 700 kPa)	0 to 150 PSI (0 to 1000 kPa)
6-Pin									
Basic Element	Absolute	Case 867-08	---	---	---	MPX5100A	---	---	---
	Differential	Case 867-08	MPX5010D	MPX5050D	MPX5100D	---	MPX5500D	MPX5700D	MPX5999D
Ported Element	Absolute Port	Case 867B-04	---	---	---	MPX5100AP	---	---	---
	Absolute Stovepipe	Case 867E-03	---	---	---	MPX5100AS	---	---	---
	Absolute Axial	Case 867F-03	---	---	---	MPX5100ASX	---	---	---
	Differential Port	Case 867C-05	MPX5010DP	MPX5050DP	MPX5100DP	---	MPX5500DP	MPX5700DP	---
	Gauge	Case 867B-04	MPX5010GP	MPX5050GP	MPX5100GP	---	MPX5500GP	MPX5700GP	---
	Gauge Vacuum	Case 867D-04	MPX5010GVP	MPX5050GVP	MPX5100GVP	---	---	---	---
	Gauge Stovepipe	Case 867E-03	MPX5010GS	MPX5050GS	MPX5100GS	---	MPX5500GS	MPX5700GS	---
	Gauge Vacuum Stovepipe	Case 867A-04	MPX5010GVS	MPX5050GVS	MPX5100GVS	---	---	---	---
	Gauge Axial	Case 867F-03	MPX5010GSX	MPX5050GSX	MPX5100GSX	---	MPX5500GSX	MPX5700GSX	---
	Gauge Vacuum Axial	Case 867G-03	MPX5010GVSX	MPX5050GVSX	MPX5100GVSX	---	---	---	---

**Table 12. MPX7000 Series (Temperature Compensated and Calibrated High Impedance On-Chip)**

Device Type	Measurement Options	Package Options	Pressure Range		
			0 to 7.3 PSI (0 to 50 kPa)	0 to 14.5 PSI (0 to 100 kPa)	0 to 29 PSI (0 to 200 kPa)
4-Pin					
Basic Elements	Absolute	Case 344-15	---	MPX7100A	MPX7200A
	Differential	Case 344-15	MPX7050D	MPX7100D	MPX7200D
Ported Elements	Absolute Port	Case 350-05	---	MPX7100AP	MPX7200AP
	Absolute Stovepipe	Case 371-07	---	MPX7100AS	---
	Absolute Axial	Case 371C-03	---	---	---
	Differential Port	Case 352-03	MPX7050DP	MPX7100DP	MPX7200DP
	Gauge	Case 350-05	MPX7050GP	MPX7100GP	MPX7200GP
	Gauge Vacuum	Case 350-06	---	MPX7100GVP	---
	Gauge Stovepipe	Case 371-07	MPX7050GS	MPX7100GS	---
	Gauge Vacuum Stovepipe	Case 371-08	---	---	---
	Gauge Axial	Case 371C-03	MPX7050GSX	MPX7100GSX	---
Gauge Vacuum Axial	Case 371D-03	---	MPX7100GVSX	---	

## Next Generation Package Options

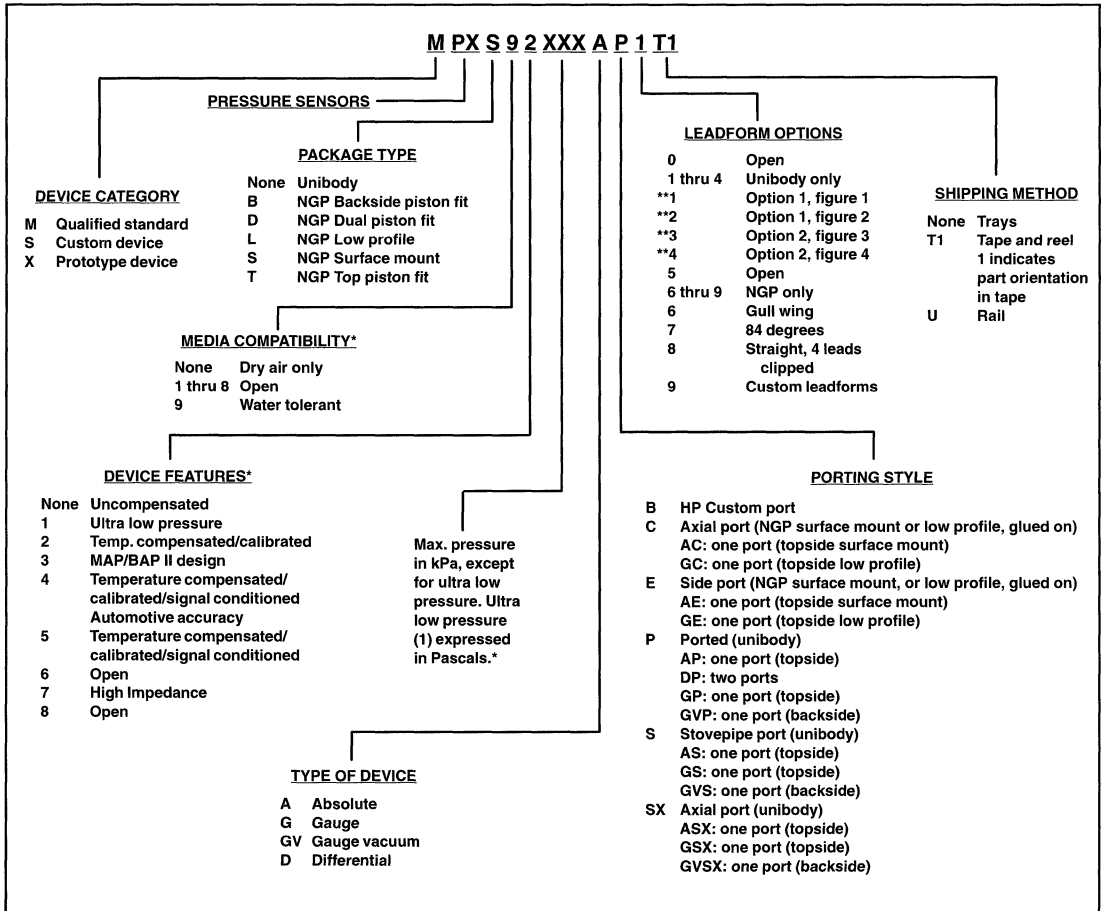
Next Generation pressure sensor packages provide surface mount and various piston fit options for pressure sensor devices. Refer to the "Device Numbering System for Pressure Sensors" to ascertain your packaging selection.

Device Type	Measurement Options	Package Options	Pressure Range			
			0 to 1.45 PSI (0 to 10 kPa)	3 to 5 PSI (20 to 105 kPa)	2.2 to 16.7 PSI (15 to 115 kPa)	3 to 36.2 PSI (20 to 250 kPa)
MPXS4100A	Absolute	Case 432-01		MPXS4100A	—	—
MPXS4115A	Absolute	Cases 432-01, 432A-01, 450B-01			MPXS4115A	
MPXT2010G	Gauge	Case 434A-02	MPXT2010A			

**Table 13. New Products (Pressure Sensor)**

Device Series	Data Sheet	Engineering Samples Available	Introduction Date	Description
MPXB5050G Backside piston fit	1Q97	1Q97	March	0 to 50 kPa, on-chip signal conditioned, 0.2 V to 4.7 V output, temperature compensated and calibrated silicon pressure sensors. Applications: Medical equipment, appliances, heavy industrial equipment and transportation equipment and systems
MPXT5006 Top piston fit	3Q97	3Q97	July	0 to 6 kPa, on-chip signal conditioned, temperature compensated and calibrated sensor. Applications: Washing machines and other consumer white goods
MPXL5010 Low profile	2Q97	2Q97	June	0 to 10 kPa, on-chip signal conditioned, temperature compensated and calibrated pressure sensor. Applications: Medical equipment, appliances, heavy industrial equipment and transportation equipment and systems
MPXT4105 Top piston fit	2Q97	2Q97	June	0 to 5 kPa, on-chip signal conditioned, 0.2 V to 4.8 V output, temperature compensated and calibrated pressure sensor. Applications: Altimeters, barometers

# Device Numbering System for Pressure Sensors



Note: Actual device marking may be abbreviated due to space constraints but packaging label will reflect full part number.

\*Only applies to qualified and prototype devices. This does not apply to custom devices.

Examples: MPX100AP 100 kPa uncompensated, absolute device in unibody package with one port (topside), no leadform, shipped in trays.  
MPXS4100A6U 100 kPa automotive temp. compensated and calibrated device with signal conditioning, NGP surface mount with gull wing leadform, shipped in rails

\*\*Note: Lead description

Lead option/Die Configuration

- 1 Option 1, up
- 2 Option 1, down
- 3 Option 2, up
- 4 Option 2, down
- 5 Open

## ACCELERATION SENSOR PRODUCTS

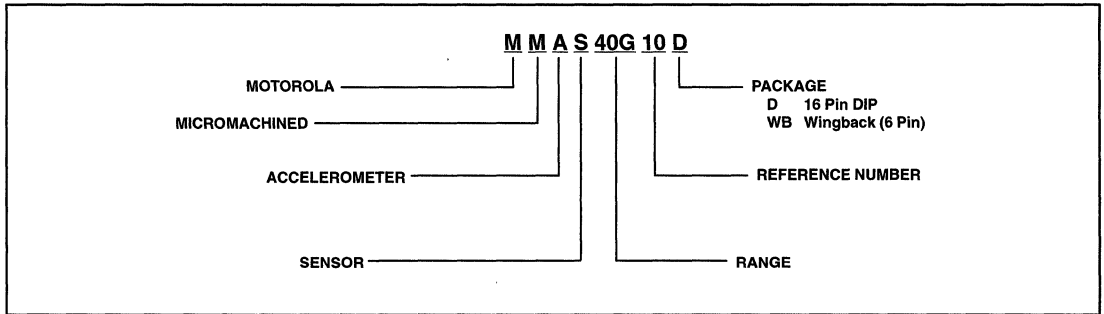
**Table 14. Accelerometer Sensor**

Device	Range	Sensitivity	Frequency/ Bandwidth (Hz)	Sensing Direction	Supply Current (mA)	Zero Acceleration Output
MMAS40G10D	±40g	40 mV/g	400	Z	7	2.5
XMMAS40GWB	±40g	40 mV/g	400	X	7	2.5

**Table 15. New Products (Accelerometer)**

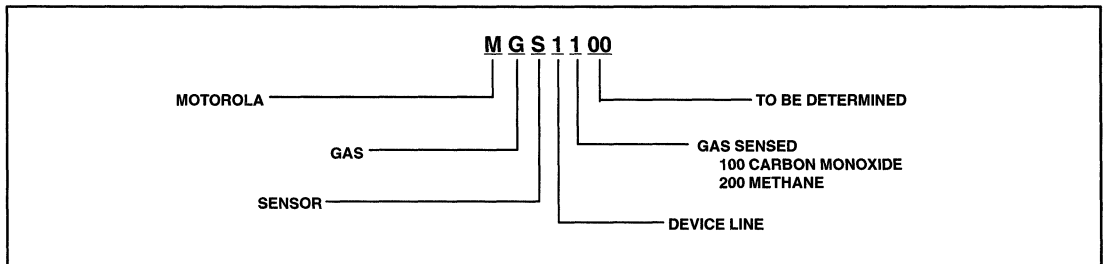
Device Series	Data Sheet	Engineering Samples Available	Introduction Date	Description
XMMAS40GWB	3Q97	3Q97	3Q97	40 g Lateral Sensing Accelerometer (Wingback)

## Device Numbering System for Accelerometers



## GAS SENSOR PRODUCTS

Device	Gas Sensitive	Sensitivity	R <sub>S</sub> (Air)	R <sub>S</sub> (100 ppm CO)	P <sub>D</sub>
MGS1100	Carbon Monoxide (CO)	15 to 1000 ppm	1000 kΩ	100 kΩ	80 mW



## EVALUATION TOOLS

**Table 16. Evaluation Kits**

Order Information	Description	Board Title/ Application Note	Max Pressure Rating	
			psi	kPa
KITDEVB114/D	Pressure Sensor with Microprocessor — Integrated A Simple Sensor Interface Amplifier — Compensated CO Gas Sensor Evaluation Kit (Preliminary)	DEVB-114/AN1305/D	14.5	100
KITDEVB173/D		DEVB-173/AN1324/D	14.5	100
KITDEVBMGS1100/D		MGS1100/D	N/A	N/A

**Table 17. New Literature**

Literature	Description
AN1559/D	Application Considerations for a Switched Capacitor Accelerometer Digital Blood Pressure Meter Understanding Pressure and Pressure Measurement +2g Acceleration Sensing Module Based on a +40g Integrated Accelerometer Motorola's Next Generation Piston Fit Pressure Sensor Packages "Very Low-Pressure" Smart Sensing Solution with Serial Communications Interface High-Performance, Dynamically-Compensated Smart Sensor System Designing a Homemade Digital Output for Analog Voltage Output Sensors
AN1571/D	
AN1573/D	
AN4004/D	
AN1583/D	
AN1584/D	
AN1585/D	
AN1586/D	

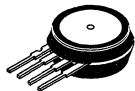
## REFERENCE TABLE

**Table 18. Pressure Unit Conversion Constants** (Most Commonly Used — Per International Conventions)

	PSI <sup>(1)</sup>	in. H <sub>2</sub> O <sup>(2)</sup>	in. Hg <sup>(3)</sup>	K Pascal	millibar	cm H <sub>2</sub> O <sup>(4)</sup>	mm Hg <sup>(5)</sup>
PSI <sup>(1)</sup>	1.000	27.681	2.036	6.8948	68.948	70.309	51.715
in. H <sub>2</sub> O <sup>(2)</sup>	$3.6126 \times 10^{-2}$	1.000	$7.3554 \times 10^{-2}$	0.2491	2.491	2.5400	1.8683
in. Hg <sup>(3)</sup>	0.4912	13.595	1.000	3.3864	33.864	34.532	25.400
K Pascal	0.14504	4.0147	0.2953	1.000	10.000	10.1973	7.5006
millibar	0.01450	0.40147	0.02953	0.100	1.000	1.01973	0.75006
cm H <sub>2</sub> O <sup>(4)</sup>	$1.4223 \times 10^{-2}$	0.3937	$2.8958 \times 10^{-2}$	0.09806	0.9806	1.000	0.7355
mm Hg <sup>(5)</sup>	$1.9337 \times 10^{-2}$	0.53525	$3.9370 \times 10^{-2}$	0.13332	1.3332	1.3595	1.000

## PRESSURE PACKAGING OPTIONS

### 4-PIN



**BASIC ELEMENT**  
CASE 344-15  
SUFFIX A/D



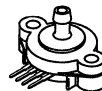
**GAUGE PORT**  
CASE 350-05  
SUFFIX AP/GP



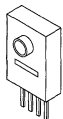
**GAUGE VACUUM PORT**  
CASE 350-06  
SUFFIX GVP



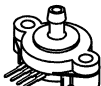
**DUAL PORT**  
CASE 352-03  
SUFFIX DP



**AXIAL PORT**  
CASE 371C-03  
SUFFIX ASX/GSX



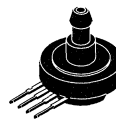
**MEDICAL CHIP PACK**  
CASE 423-04



**AXIAL VACUUM PORT**  
CASE 371D-03  
SUFFIX GVSX

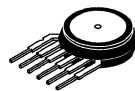


**STOVEPIPE PORT**  
CASE 371-07  
SUFFIX GVS



**STOVEPIPE VACUUM PORT**  
CASE 371-08  
SUFFIX AS/GS

### 6-PIN



**BASIC ELEMENT**  
CASE 867-08  
SUFFIX A/D



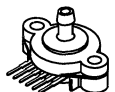
**GAUGE PORT**  
CASE 867B-04  
SUFFIX AP/GP



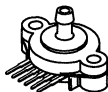
**GAUGE VACUUM PORT**  
CASE 867D-04  
SUFFIX GVP



**DUAL PORT**  
CASE 867C-05  
SUFFIX DP



**AXIAL PORT**  
CASE 867F-03  
SUFFIX ASX/GSX



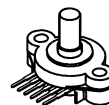
**AXIAL VACUUM PORT**  
CASE 867G-03  
SUFFIX GVSX



**STOVEPIPE PORT**  
CASE 867E-03  
SUFFIX AS/GS

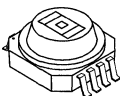


**STOVEPIPE VACUUM PORT**  
CASE 867A-04  
SUFFIX GVS



**STOVEPIPE MEDIA PORT**  
CASE 867H-03  
SUFFIX GVW

### 8-PIN (NEW)



**BACKSIDE PISTON FIT**  
CASE 450E-01



**SURFACE MOUNT**  
CASE 432-01



**TOP PISTON FIT**  
CASE 432A-01



**TOP PISTON FIT**  
CASE 434A-03

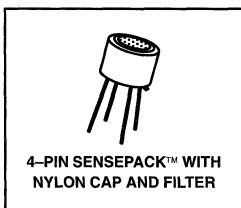


**DUAL PISTON FIT**  
CASE 434C-01

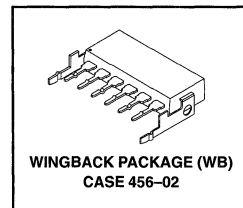
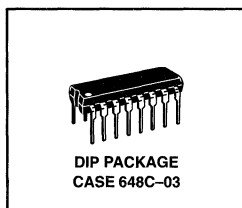


**SURFACE MOUNT**  
CASE 450B-01

### CHEMICAL SENSOR PACKAGING



### ACCELEROMETER PACKAGING



# RF Products

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## In Brief . . .

While Motorola is considered to be the supermarket for semiconductor products, there is not a category in which the selection is more diverse, or more complete, than in products designed for RF system applications. From MOS, bipolar power and signal transistors to integrated circuits, Motorola's RF components cover the entire spectrum from HF to microwave to personal communications. Yet, product expansion continues — not only to keep pace with the progressive needs of the industry, but to better serve the needs of designers for a reliable and comprehensive source of supply.

## How to Use This Selector Guide

This new selector guide combines the RF products of Motorola Phoenix, Motorola Toulouse (France), and Motorola Hong Kong. The products in this guide are separated FIRST into major categories such as Power FETs, Power Bipolar, Medium Power Transistors, Small Signal, Monolithic Integrated Circuits, Power Amplifier Modules and CATV Distribution Amplifiers. SECOND, within each category parts are listed by frequency band, except for medium power transistors, small signal transistors and monolithic integrated circuits, which are divided by application. Small signal transistor applications are low noise, linear amplifiers, switches, and oscillators. Monolithic integrated circuit application groupings are switching, receiver functions and transmitter functions. THIRD, within a frequency band, transistors are further grouped by operating voltage and, finally, output power.

### Remember

Applications assistance is only a phone call away — call the nearest Semiconductor Sales office or 1-800-521-6274.

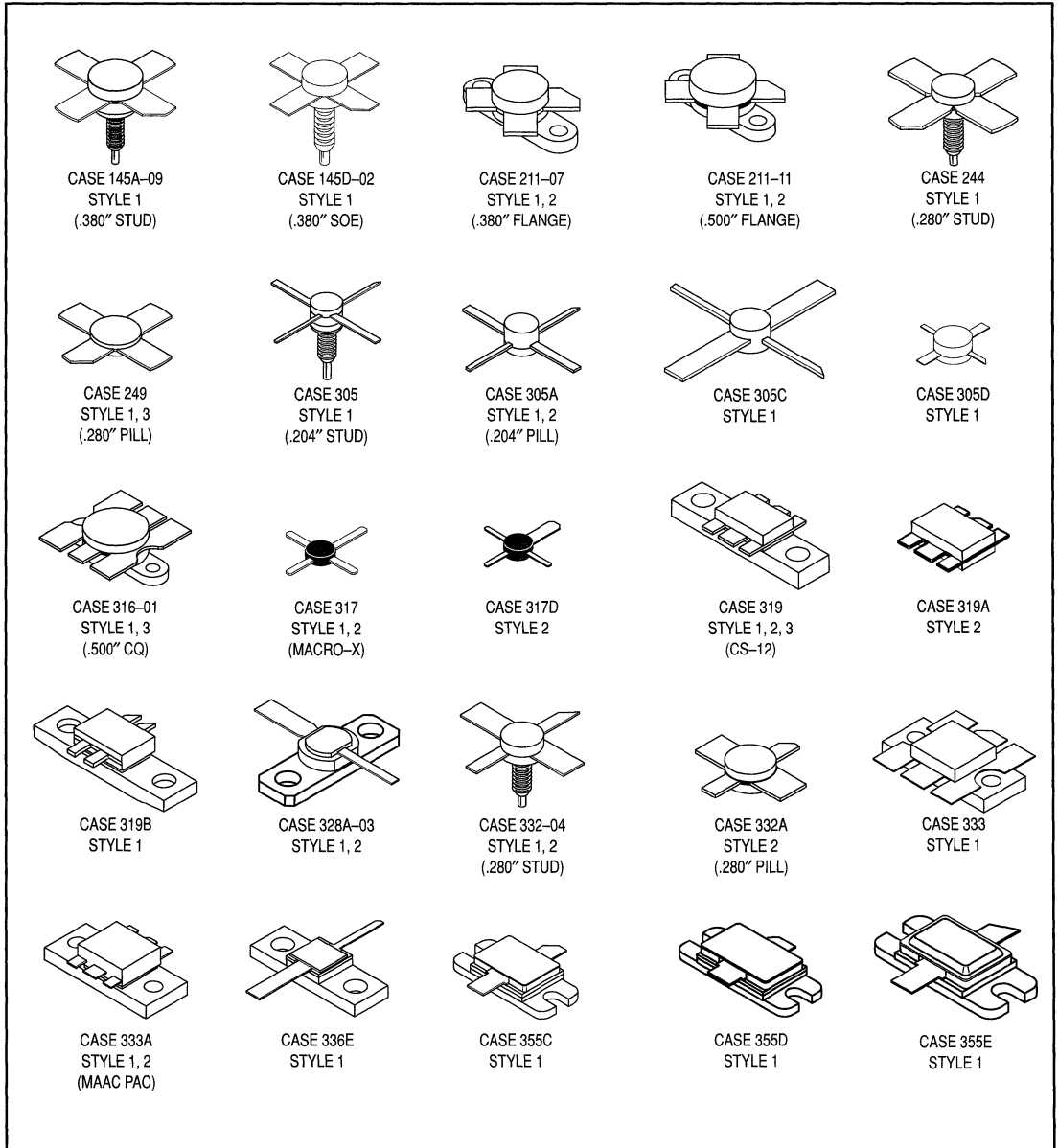
	<b>Page</b>
RF Discrete Transistors . . . . .	5.10-2
RF Power MOSFETs . . . . .	5.10-4
RF Power Bipolar Transistors . . . . .	5.10-7
HF Transistors . . . . .	5.10-7
VHF Transistors . . . . .	5.10-7
UHF Transistors . . . . .	5.10-8
900 MHz Transistors . . . . .	5.10-9
1.5 GHz Transistors . . . . .	5.10-10
Microwave Transistors . . . . .	5.10-10
Linear Transistors . . . . .	5.10-12
RF Medium Power Transistors . . . . .	5.10-14
Discrete Wireless Transmitter Devices . . . . .	5.10-15
RF Small Signal Transistors . . . . .	5.10-16
Selection by Package . . . . .	5.10-17
Plastic SOE Case . . . . .	5.10-17
Ceramic SOE Case . . . . .	5.10-20
Selection by Application . . . . .	5.10-21
Low Noise . . . . .	5.10-21
CATV, MATV and Class A Linear . . . . .	5.10-22
RF Monolithic Integrated Circuits . . . . .	5.10-23
Switching . . . . .	5.10-24
Antenna Switches . . . . .	5.10-24
Receiver Functions . . . . .	5.10-24
General Purpose Integrated Circuits . . . . .	5.10-24
900 MHz Front End . . . . .	5.10-24
1.5-2.2 GHz Front End . . . . .	5.10-24
2.4 GHz Front End . . . . .	5.10-25
Transmitter Functions . . . . .	5.10-25
General Purpose Integrated Circuits . . . . .	5.10-25
900 MHz Transmit Chain . . . . .	5.10-26
1.5-2.2 GHz Transmit Chain . . . . .	5.10-27
2.4 GHz Transmit Chain . . . . .	5.10-28
RF Amplifier Modules . . . . .	5.10-29
Land Mobile/Portable . . . . .	5.10-31
Wideband Linear Amplifiers . . . . .	5.10-34
TV Transmitters . . . . .	5.10-35
CATV Distribution Amplifiers . . . . .	5.10-36
Fiber Optic Receivers . . . . .	5.10-36
Forward Amplifiers . . . . .	5.10-36
Reverse Amplifiers . . . . .	5.10-40

# RF Discrete Transistors

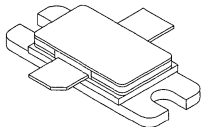
In the following pages, the reader will find the most extensive group of RF Discrete Transistors offered by any semiconductor manufacturer anywhere in the world today.

From Bipolar to FET, from Low Power to High Power, the user can choose from a variety of packages. They include plastic, metal can and ceramic that are microstrip circuit compatible or surface mountable. Many are designed for automated assembly equipment.

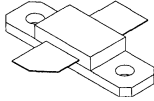
Major sub-headings are MOSFETs, Power Bipolar and Small Signal.







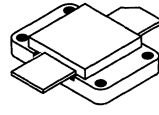
CASE 355H-01  
STYLE 1



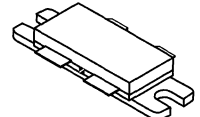
CASE 360B  
STYLE 1  
(Micro 250)



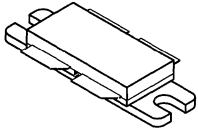
CASE 360C  
STYLE 1



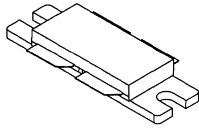
CASE 368  
STYLE 2  
(HOG PAC)



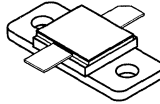
CASE 375  
STYLE 2



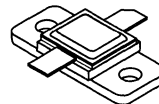
CASE 375A  
STYLE 1



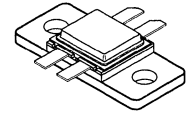
CASE 375B  
STYLE 2  
(Micro 860)



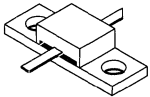
CASE 376B  
STYLE 1



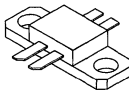
CASE 376C  
STYLE 1



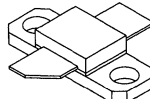
CASE 391  
STYLE 1



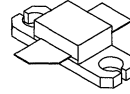
CASE 394  
STYLE 1



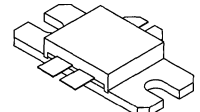
CASE 395B  
STYLE 1



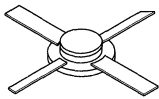
CASE 395C  
STYLE 1, 2



CASE 395D  
STYLE 1



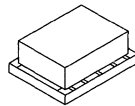
CASE 398  
STYLE 1



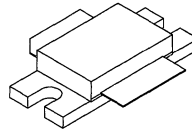
CASE 400  
STYLE 1



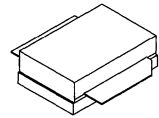
CASE 430  
STYLE 2



CASE 430B  
STYLE 1



CASE 451  
STYLE 1



CASE 451A  
STYLE 1



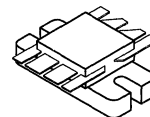
CASE 458  
STYLE 1



CASE 458A  
STYLE 1



CASE 466  
STYLE 1  
(PLD -1.5)



CASE 744A  
STYLE 1, 2



CASE 751  
STYLE 1  
(SO-8)

# RF Power MOSFETs

Motorola RF Power MOSFETs are constructed using a planar process to enhance manufacturing repeatability. They are *N-channel field effect transistors* with an oxide insulated gate which controls vertical current flow.

Compared with bipolar transistors, RF Power FETs exhibit higher gain, higher input impedance, enhanced thermal stability and lower noise. The FETs listed in this section are specified for operation in RF Power Amplifiers and are grouped by frequency range of operation and type of application. Arrangement within each group is first by order of voltage then by increasing output power.

**Table 1. To 54 MHz**

Designed for broadband HF/SSB commercial and industrial applications. The high gain, broadband performance and linear characterization of this device makes it ideal for large-signal, common-source amplifier applications in 12.5 volt mobile and amateur radio transmitters.

Device	P <sub>out</sub> Output Power Watts	P <sub>in</sub> Input Power Typical Watts	G <sub>ps</sub> (Typ)/Freq. dB/MHz	η Eff., Typ %	Typical IMD		θ <sub>JC</sub> °C/W	Package/Style
					d <sub>3</sub> dB	d <sub>5</sub> dB		
<b>V<sub>CC</sub> = 12.5 Volts, Class AB</b>								
MRF255	55	0.8	16/54	45	-30	-30	1.0	211-11/2

**Table 2. To 150 MHz HF/SSB**

For military and commercial HF/SSB fixed, mobile and marine transmitters.

Device	P <sub>out</sub> Output Power Watts	P <sub>in</sub> Input Power Typical Watts	G <sub>ps</sub> Typical Gain dB @ 30 MHz	Typical IMD		θ <sub>JC</sub> °C/W	Package/Style
				d <sub>3</sub> dB	d <sub>11</sub> dB		
<b>V<sub>DD</sub> = 28 Volts, Class AB</b>							
MRF140	150	4.7	15	-30	-60	0.6	211-11/2
<b>V<sub>DD</sub> = 50 Volts, Class AB</b>							
MRF148	30	0.5	18	-35	-60	1.5	211-07/2
MRF150	150	3	17	-32	-60	0.6	211-11/2
MRF154	600	12	17	-25	—	0.13	368/2
MRF157	600	6	20	-25	—	0.13	368/2

**Table 3. To 225 MHz VHF AM/FM**

For VHF military and commercial aircraft radio transmitters.

Device	P <sub>out</sub> Output Power Watts	P <sub>in</sub> Input Power Typical Watts	G <sub>ps</sub> (Typ)/Freq. dB/MHz	η Efficiency Typical %	θ <sub>JC</sub> °C/W	Package/Style
<b>V<sub>DD</sub> = 28 Volts, Class AB</b>						
MRF134	5	0.2	14/150	55	10	211-07/2
MRF136	15	0.38	16/150	60	3.2	211-07/2
MRF136Y	30	1.2	14/150	54	1.8	319B/1
MRF137	30	0.75	16/150	60	1.8	211-07/2
MRF173	80	4	13/150	65	0.8	211-11/2
MRF173CQ	80	4	13/150	65	0.8	316-01/2
MRF175LV	100	4	14/225	65	0.65	333/1
MRF174	125	8.3	11.8/150	60	0.65	211-11/2
MRF141	150	15	10/175	55	0.6	211-11/2
MRF175GV	200	8	14/225	65	0.44	375/2
MRF141G	300	30	10/175	55	0.35	375/2
<b>V<sub>DD</sub> = 50 Volts, Class AB</b>						
MRF151	150	7.5	13/175	45	0.6	211-11/2
MRF176GV	200	4	17/225	55	0.44	375/2
MRF151G	300	7.5	16/175	55	0.35	375/2

**Table 4. To 500 MHz VHF/UHF AM/FM**

For VHF/UHF military and commercial aircraft radio transmitters.

Device	P <sub>out</sub> Output Power Watts	P <sub>in</sub> Input Power Typical Watts	G <sub>ps</sub> (Typ)/Freq. dB/MHz	η Eff., Typ %	θ <sub>JC</sub> °C/W	Package/Style
<b>V<sub>DD</sub> = 28 Volts, Class AB</b>						
MRF158	2	0.02	20/400	55	13.2	305A/2
MRF160	4	0.08	17/400	50	7.2	249/3
MRF166C	20	0.4	17/400	55	2.5	319/3
MRF175LU	100	10	10/400	55	0.65	333/1
MRF177	100	6.4	12/400	60	0.65	744A/2
MRF175GU	150	9.5	12/400	55	0.44	375/2
MRF275L(46a)	100	12.5	9/500	55	0.65	333/1
MRF275G(46a)	150	11.9	11/500	55	0.44	375/2
<b>V<sub>DD</sub> = 50 Volts, Class AB</b>						
MRF176GU	150	6	14/400	50	0.44	375/2

**Table 5. To 520 MHz**

Designed for broadband VHF &amp; UHF commercial and industrial applications. The high gain and broadband performance of these devices make them ideal for large-signal, common-source amplifier applications in 12.5/7.5 volt mobile, portable and base station operation.

Device	P <sub>out</sub> Output Power Watts	P <sub>in</sub> Input Power Typical Watts	G <sub>ps</sub> (Typ)/Freq. dB/MHz	η Eff., Typ %	θ <sub>JC</sub> °C/W	Package/Style
<b>V<sub>DD</sub> = 7.5 Volts, Class AB – LDMOS Die</b>						
MRF1507 (46b)	8	0.630	11	65	2.0	PLD-1.5
<b>V<sub>CC</sub> = 7.5 Volts, Class AB</b>						
MRF5003(18a)	3	0.27	10.5/512	50	14	430/2
MRF5007(18a)	7	0.5	11.5/512	55	5	430B/1
<b>V<sub>CC</sub> = 12.5 Volts, Class AB</b>						
MRF5015	15	1.1	11.5/512	55	3.5	319/3
MRF5035	35	6.3	7.5/512	55	1.8	316-01/3

**520 MHz, V<sub>DD</sub> = 48 Volts, VHF/UHF for Conventional FM, Class AB – LDMOS Die**

MRF190S (46c)	15 CW	0.75	13/520	55	2.5	458/1
MRF191 (46c)	30 CW	1.5	13/520	55	2.2	360B/1
MRF191S (46c)	30 CW	1.5	13/520	55	2.2	360C/1
MRF192 (46c)	60 CW	3.0	13/520	55	1.2	360B/1
MRF192S (46c)	60 CW	3.0	13/520	55	1.2	360B/1
MRF193 (46e)	120 CW	6.0	13/520	55	0.6	Similar to 375B/2
MRF194 (46e)	150 CW	7.5	13/520	55	0.55	Single-ended Device

(18) Tape and Reel Packaging Option Available by adding suffix: a) R1 = 500 units; b) R2 = 2,500 units; c) T1 = 3,000 units; d) T3 = 10,000 units; e) R2 = 1,500 units; f) T1 = 1,000 units.

(46) To be introduced: a) 1Q97; b) 2Q97; c) 3Q97; d) 3Q97; e) 4Q97

## RF Power MOSFETs (continued)

**Table 6. To 900 MHz**

Device	P <sub>out</sub> Output Power Watts	P <sub>in</sub> Input Power Typical Watts	G <sub>ps</sub> (Typ)/Freq. dB/MHz	η Eff., Typ %	θ <sub>JC</sub> °C/W	Package/Style
<b>900 MHz, V<sub>DD</sub> = 48 Volts, Class AB – LDMOS Die</b>						
MRF195S (46c)	15 PEP	0.75	13/900	33	2.5	458/1
MRF196 (46e)	30 PEP	1.5	13/900	33	2.2	360B/1
MRF196S (46e)	30 PEP	1.5	13/900	33	2.2	360C/1
MRF197 (46c)	60 PEP	3.0	13/900	33	1.2	360B/1
MRF197S (46c)	60 PEP	3.0	13/900	33	1.2	360C/1
MRF198 (46e)	90 PEP	4.5	13/900	33	1.0	Single-ended Device
MRF199 (46e)	150 PEP	15	10/900	33	0.55	Single-ended Device

**Table 7. To 1.0 GHz**

For HF/VHF/UHF commercial and military radio transmitters.

Device	P <sub>out</sub> Output Power Watts	P <sub>in</sub> Input Power Typical Watts	G <sub>ps</sub> (Typ)/Freq. dB/MHz	η Eff., Typ %	θ <sub>JC</sub> °C/W	Package/Style
<b>1.0 GHz, V<sub>DD</sub> = 26 Volts, Class AB – LDMOS Die</b>						
MRF6522–5 (46b)	5	0.08	18/960	55	10	458A/1
MRF6522–10 (46b)	10	0.20	17/960	55	6.0	458A/1
<b>1.0 GHz, V<sub>DD</sub> = 28 Volts, Class AB – LDMOS Die</b>						
MRF181S (46a)	4	0.16	14/1000	40	3.6	458/1
MRF181Z (46b)	4	0.16	14/1000	40	3.6	458A/1
MRF182★	30	1.2	14/1000	60	1.75	360B/1
MRF182S★	30	1.2	14/1000	60	1.75	360C/1
MRF183★	45	1.8	14/1000	60	1.5	360B/1
MRF183S★	45	1.8	14/1000	60	1.5	360C/1
MRF184★	60	1.9	15/1000	60	1.1	360B/1
MRF184S★	60	1.9	15/1000	60	1.1	360C/1
MRF185 (3)★	85	3.4	14/1000	55	0.7	375B/2
MRF186 (3,46b)	120	7.6	12/1000	55	0.6	375B/2

**Table 8. To 1.6 GHz**

**1.6 GHz, V<sub>DD</sub> = 28 Volts, Class AB, Characterized for INMARSAT Uplinks–LDMOS Die**

MRF3010 (46b)	10	0.95	11/1600	57	3.6	360B/1
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(3) Internal Impedance Matched Push-Pull Transistors

(46) To be introduced: a) 1Q97; b) 2Q97; c) 3Q97; d) 3Q97; e) 4Q97

★ New Product

# RF Power Bipolar Transistors

Motorola's broad line of bipolar RF power transistors are characterized for operation in RF power amplifiers. Typical applications are in base stations, military and commercial landmobile, avionics and marine radio transmitters. Groupings are by frequency band and type of application. Within each group, the arrangement of devices is by major supply voltage rating, then in the order of increasing output power. All devices are NPN polarity except where otherwise noted.

## HF Transistors

**Table 1. 1.5 – 30 MHz, HF/SSB**

Designed for broadband operation, these devices feature specified Intermodulation Distortion at rated power output. Applications include mobile, marine, fixed station, and amateur HF/SSB equipment, operating from 12.5, 13.6, 28, or 50 volt supplies.

Device	P <sub>out</sub> Output Power Watts	P <sub>in</sub> (Max) Input Power Watts	G <sub>pE</sub> (Min) Gain @ 30 MHz dB	θ <sub>JC</sub> °C/W	Package/Style
<b>V<sub>CC</sub> = 12.5 or 13.6 Volts, Class AB</b>					
MRF421	100 PEP/CW	10	10	0.6	211–11/1
<b>V<sub>CC</sub> = 28 Volts, Class AB</b>					
MRF426	25 PEP/CW	0.16	22	2.5	211–07/1
MRF422	150 PEP/CW	15	10	0.6	211–11/1
<b>V<sub>CC</sub> = 50 Volts, Class AB</b>					
MRF429	150 PEP/CW	7.5	13	0.8	211–11/1
MRF448	250 PEP/CW	15.7	12	0.6	211–11/1

**Table 2. 14 – 30 MHz, CB/Amateur Band**

These HF transistors are designed for economical, high-volume use in CW, AM and SSB applications.

**V<sub>CC</sub> = 12.5 or 13.6 Volts, Class AB**

MRF455	60	3	13	1	211–07/1
MRF454	80	5	12	0.7	211–11/1

**Table 3. 27 – 50 MHz, Low-Band FM Band**

For use in the FM "Low-Band," for Mobile communications.

Device	P <sub>out</sub> Output Power Watts	P <sub>in</sub> (Max) Input Power Watts	G <sub>pE</sub> (Min) Gain @ 50 MHz dB	θ <sub>JC</sub> °C/W	Package/Style
<b>V<sub>CC</sub> = 12.5 or 13.6 Volts, Class AB</b>					
MRF492	70	5.6	11	0.7	211–11/1

## VHF Transistors

**Table 4. 30 – 200 MHz Band**

Designed for Military Radio and Commercial Aircraft VHF bands, these 28-volt devices include the all-gold metallized MRF314/16/17 high-reliability series.

Device	P <sub>out</sub> Output Power Watts	P <sub>in</sub> (Max) Input Power Watts	G <sub>pE</sub> (Min)/Freq. Power Gain dB/MHz	θ <sub>JC</sub> °C/W	Package/Style
<b>V<sub>CC</sub> = 28 Volts, Class AB</b>					
MRF314	30	3	10/150	2.2	211–07/1
MRF316 <sup>(2)</sup>	80	8	10/150	0.8	316–01/1
MRF317 <sup>(2)</sup>	100	12.5	9/150	0.65	316–01/1

<sup>(2)</sup>Internal Impedance Matched

## VHF Transistors (continued)

**Table 5. 136 – 174 MHz High Band**

The “workhorse” VHF FM High-Band is served by Motorola with the broadest range of devices and package combinations in the industry.

Device	P <sub>out</sub> Output Power Watts	P <sub>in</sub> (Max) Input Power Watts	G <sub>PE</sub> (Min) Gain @ 175 MHz dB	θ <sub>JC</sub> °C/W	Package/Style
<b>VCC = 12.5 Volts, Class C</b>					
MRF4427(18b)	1	0.016	18(19)	125(1)	751/1
MRF553	1.5	0.11	11.5	25	317D/2
MRF2628	15	0.95	12	4	244/1
MRF1946	30	3	10	1.6	211-07/1
MRF1946A	30	3	10	1.8	145A-09/1
MRF224	40	14.3	4.5	2.2	211-07/1
MRF240	40	5	9	2.2	145A-09/1
MRF247(2)	75	15	7	0.7	316-01/1

## UHF Transistors

**Table 6. 100 – 400 MHz Band**

Stringent requirements of the UHF Military band are met by MRF325, 326, 327, 329 and 2N6439 types, with all-gold metal systems, specified ruggedness and programmed wirebond construction, to assure consistent input impedances for internally matched parts.

Device	P <sub>out</sub> Output Power Watts	P <sub>in</sub> (Max) Input Power Watts	G <sub>PE</sub> (Min) Gain @ 400 MHz dB	θ <sub>JC</sub> °C/W	Package/Style
<b>VCC = 28 Volts, Class C</b>					
MRF325(2)	30	4.3	8.5	2.2	316-01/1
MRF326(2)	40	5	9	1.6	316-01/1
MRF327(2)	80	14.9	7.3	0.7	316-01/1
MRF329(2)	100	20	7	0.7	333/1
MRF392(3)	125	19.8	8	0.7	744A/1

**Table 7. 400 – 500 MHz Band**

Similar to the 100–400 MHz transistors, these devices have bandwidth capabilities operating up to 500 MHz. All have nitride passivated die, gold metal systems, specified ruggedness and controlled wirebond construction to meet the stringent requirements of military space applications.

Device	P <sub>out</sub> Output Power Watts	P <sub>in</sub> (Max) Input Power Watts	G <sub>PE</sub> (Min)/Freq. Power Gain dB/MHz	θ <sub>JC</sub> °C/W	Package/Style
<b>VCC = 28 Volts, Class C</b>					
MRF313	1	0.03	15/400	28.5	305A/1
MRF321	10	0.62	12/400	6.4	244/1
MRF323	20	2	10/400	3.2	244/1
MRF393(3)	100	18	7.5/500	0.7	744A/1

(1)R<sub>θJA</sub>: Thermal Resistance Junction to Ambient.

(2)Internal Impedance Matched

(3)Internal Impedance Matched Push-Pull Transistors

(18)Tape and Reel Packaging Option Available by adding suffix: a) R1 = 500 units; b) R2 = 2,500 units; c) T1 = 3,000 units; d) T3 = 10,000 units; e) R2 = 1,500 units; f) T1 = 1,000 units.

(19)Typical

## UHF Transistors (continued)

**Table 8. 470 – 512 MHz Band**

Higher power output devices in this UHF power transistor series feature internally input-matched construction, are designed for broadband operation, and have guaranteed ruggedness under output mismatch and RF overdrive conditions. Devices are specified for handheld, mobile and base station operation.

Device	P <sub>out</sub> Output Power Watts	P <sub>in</sub> (Max) Input Power Watts	G <sub>pE</sub> (Min)/Freq. Power Gain dB/MHz	θ <sub>JC</sub> °C/W	Package/Style
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**V<sub>CC</sub> = 12.5 Volts, Class C**

MRF581 <sup>(4)</sup>	0.6	0.03	13/500	40	317/2
MRF555	1.5	0.15	10/470	25	317D/2
MRF652	5	0.5	10/512	7	244/1
MRF652S	5	0.5	10/512	7	249/1
MRF653	10	2	7/512	4	244/1
MRF653S	10	2	7/512	4	249/1
MRF641 <sup>(2)</sup>	15	2.5	7.8/470	4	316-01/1
MRF654 <sup>(2)</sup>	15	2.5	7.8/512	4	244/1
MRF644 <sup>(2)</sup>	25	5.9	6.2/470	1.7	316-01/1
MRF650 <sup>(2)</sup>	50	15.8	5.0/512	1.3	316-01/1
MRF658 <sup>(2)</sup>	65	25	4.15/512	1	316-01/1

Device	P <sub>out</sub> Output Power Watts	Class	P <sub>in</sub> (Max) Input Power Watts	G <sub>pE</sub> (Min)/Freq. Power Gain dB/MHz	θ <sub>JC</sub> °C/W	Package/Style
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**V<sub>CC</sub> = 24 Volts**

TP5002S	1.5	A	0.075	13/470	21	249/1
TP5015	15	AB	1.2	11/470	7.0	319/2
TP5051	50	AB	6	9/470	1.2	333A/2

## 900 MHz Transistors

**Table 9. 870 – 960 MHz Band**

Designed specifically for the 900 MHz mobile radio band, MRF840 through MRF847 devices offer superior gain and ruggedness, using the unique CS-12 package, which minimizes common-element impedance, and thus maximizes gain and stability. Devices are listed for mobile and base station applications.

Device	P <sub>out</sub> Output Power Watts	P <sub>in</sub> (Max) Input Power Watts	G <sub>pE</sub> (Min)/Freq. Power Gain dB/MHz	θ <sub>JC</sub> °C/W	Package/Style
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**V<sub>CC</sub> = 12.5 Volts — Class C — Si Bipolar**

MRF559 <sup>(5)</sup>	0.5	0.08	8/870	50	317/2
MRF581 <sup>(5)</sup>	0.6	0.06	10 <sup>(19)</sup> /870	40	317/2
MRF837 <sup>(5)</sup>	0.75	0.11	8/870	40	317/1
MRF8372R1 <sup>(5)</sup> (18a,b)	0.75	0.11	8/870	45	751/1
MRF557 <sup>(5)</sup>	1.5	0.23	8/870	25	317D/2
MRF840 <sup>(2)</sup> <sup>(6)</sup>	10	2.5	6/870	3.1	319/1
MRF842 <sup>(2)</sup> <sup>(6)</sup>	20	5	6/870	1.5	319/1
MRF847 <sup>(2)</sup> <sup>(6)</sup>	45	16	4.5/870	1	319/1

<sup>(2)</sup>Internal Impedance Matched

<sup>(4)</sup>Small signal gain. P<sub>o</sub> is Typ.

<sup>(5)</sup>Common Emitter Configuration

<sup>(6)</sup>Common Base Configuration

<sup>(18)</sup>Tape and Reel Packaging Option Available by adding suffix: a) R1 = 500 units; b) R2 = 2,500 units; c) T1 = 3,000 units; d) T3 = 10,000 units; e) R2 = 1,500 units;

f) T1 = 1,000 units.

<sup>(19)</sup>Typical

## 900 MHz Transistors (continued)

**Table 9. 870 – 960 MHz Band (continued)**

Device	P <sub>out</sub> Output Power Watts	Class	P <sub>in</sub> (Max) Input Power Watts	G <sub>p</sub> (Min)/Freq. Power Gain dB/MHz	θ <sub>JC</sub> °C/W	Package/Style
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### V<sub>CC</sub> = 24 Volts — Si Bipolar

TP3007S	2	AB	0.25	9/960	21	305C/1
MRF896	3	AB	0.3	10/900	7	305E/1
TP3008	4	AB	0.28	11.5/960	5	319/2
MRF891	5	AB	0.63	9/900	7	319/2
MRF891S	5	AB	0.63	9/900	7	319A/2
TP3021	10	AB	1.0	10/960	5.0	319/2
MRF892(2)	14	C	2	8.5/900	3.5	319/1
MRF894(2)	30	C	6	7/900	1.5	319/1
MRF897(3)	30	AB	3	10/900	1.7	395B/1
MRF897R(3)	30	AB	3	10.5/900	1.7	395B/1
TP3034	35	AB	7	7/960	2.3	319/2
MRF898(2)	60	C	12	7/900	1	333A/1

### V<sub>CC</sub> = 26 Volts — Si Bipolar

MRF6409(46a)	20	AB	26/50	10/960	3.8	319/2
MRF6414	50	AB	26/200	8.5/960	1.3	333A/2
TP3069	100	AB	18	7.5/960	0.7	375A/1
MRF899(3)	150	AB	24	8/900	0.8	375A/1

## 1.5 GHz Transistors

**Table 10. 1400 – 1640 MHz Band**

Device	P <sub>out</sub> Output Power Watts	Class	η Eff. (Min) %	G <sub>p</sub> (Min)/Freq. Power Gain dB/MHz	θ <sub>JC</sub> °C/W	Package/Style
MRA1600-002	2	C	40	8.4/1600	15	394/1
MRF16006	6	C	40	7.4/1600	6.8	395C/2
MRF16030	30	C	40	7.5/1600	1.7	395C/2

## Microwave Transistors

**Table 11. L-Band Pulse Power**

These products are designed to operate in short pulse width, 10 μs, low duty cycle, 1%, power amplifiers operating in the 960–1215 MHz band. All devices have internal impedance matching. The prime application is avionics equipment for distance measuring (DME), area navigation (TACAN) and interrogation (IFF).

Device	P <sub>out</sub> Output Power Watts	P <sub>in</sub> (Max) Input Power Watts	G <sub>p</sub> (Min) Gain @ 1090 MHz dB	θ <sub>JC</sub> °C/W	Package/Style
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### V<sub>CC</sub> = 18 Volts — Class A & AB Common Emitter

MRF1000MA	0.2	0.02	10	25	332-04/2
MRF1000MB	0.2	0.02	10	25	332A/2

### V<sub>CC</sub> = 35 Volts — Class B & C Common Base

MRF1002MA	2	0.2	10	25	332-04/1
MRF1002MB	2	0.2	10	25	332A/1
MRF1004MA	4	0.4	10	25	332-04/1
MRF1004MB	4	0.4	10	25	332A/1

(2) Internal Impedance Matched

(3) Internal Impedance Matched Push-Pull Transistors

(46) To be introduced: a) 1Q97; b) 2Q97; c) 3Q97; d) 3Q97; e) 4Q97



## Microwave Transistors (continued)

Table 11. L-Band Pulse Power (continued)

Device	P <sub>out</sub> Output Power Watts	P <sub>in</sub> (Max) Input Power Watts	G <sub>p</sub> (Min) Gain @ 1090 MHz dB	θ <sub>JC</sub> °C/W	Package/Style
<b>V<sub>CC</sub> = 50 Volts — Class C Common Base</b>					
MRF1015MA	15	1.5	10	10	332-04/1
MRF1015MB	15	1.5	10	10	332A/1
MRF1035MA	35	3.5	10	5	332-04/1
MRF1035MB	35	3.5	10	5	332A/1
MRF1090MA	90	9	10	0.6	332-04/1
MRF1090MB	90	9	10	0.6	332A/1
MRF1150MA	150	25	7.8	0.3	332-04/1
MRF1150MB	150	25	7.8	0.3	332A/1

Table 12. L-Band Long Pulse Power

These products are designed for pulse power amplifier applications in the 960–1215 MHz frequency range. They are capable of handling up to 10 μs pulses in long pulse trains resulting in up to a 50% duty cycle over a 3.5 millisecond interval. Overall duty cycle is limited to 25% maximum. The primary applications for devices of this type are military systems, specifically JTIDS and commercial systems, specifically Mode S. Package types are hermetic.

Device	P <sub>out</sub> Output Power Watts	P <sub>in</sub> (Max) Input Power Watts	G <sub>pB</sub> (Min) Gain @ 1215 MHz dB	θ <sub>JC</sub> °C/W	Package/Style
<b>V<sub>CC</sub> = 28 Volts — Class C Common Base</b>					
MRF10005	5	0.71	8.5	8	336E/1
<b>V<sub>CC</sub> = 36 Volts — Class C Common Base</b>					
MRF10031	30	3	10	3	376B/1
MRF10120	120	19	8	0.6	355C/1
<b>V<sub>CC</sub> = 50 Volts</b>					
MRF10070	70	7	10 <sup>(7)</sup>	0.4	376C/1
MRF10150	150	15	10 <sup>(7)</sup>	0.25	376B/1
MRF10350	350	44	9 <sup>(7)</sup>	0.11	355E/1
MRF10500	500	63	9 <sup>(7)</sup>	0.12	355D/1
MRF10501	500	63	9 <sup>(7)</sup>	0.12	355H/1

<sup>(7)</sup>Typical @ 1090 MHz

# Linear Transistors

The following sections describe a wide variety of devices specifically characterized for linear amplification. Included are medium power and high power parts covering frequencies from 100 MHz–4 GHz.

**Table 13. To 1 GHz, Class A**

These devices offer a selection of performance and price for linear amplification to 1 GHz. The "MRA" prefix parts are input matched and feature high overdrive and extreme ruggedness capability.

Device	P <sub>O</sub> @ 1 dB Comp. Point Watts	G <sub>SS</sub> (Min)/Freq. Small Signal Gain dB/MHz	Bias Point (Vdc/A)	θ <sub>JC</sub> °C/W	Package/Style
<b>VCC = 19 Volts</b>					
MRA1000–3.5L	3.5	10/1000	19/0.6	8	145A–09/1
MRA1000–7L	7	9/1000	19/1.2	4	145D–02/1
MRA1000–14L	14	8/1000	19/2.4	2.1	145D–02/1

Device	P <sub>out</sub> Output Power Watts	G <sub>p</sub> (Min)/Freq. Power Gain dB/MHz	Bias Point Per Side (Vdc/MA)	θ <sub>JC</sub> °C/W	Package/Style
<b>VCC = 28 Volts</b>					
MRA0510–50H	50	7/1000	28/120	1.4	391–01/1

**Table 14. UHF Ultra Linear For TV Applications**

The following devices have been characterized for ultra-linear applications such as low-power TV transmitters in Band IV and Band V. Each features diffused ballast resistors and an all-gold metal system to provide enhanced reliability and ruggedness.

Device	P <sub>ref</sub> (Min) Watts	G <sub>p</sub> (Min)/Freq. Small Signal Gain dB/MHz	3 Tone IMD <sup>(8)</sup> dB	θ <sub>JC</sub> °C/W	Package/Style
<b>VCC = 20 Volts, Class A</b>					
TPV596A	0.5	11.5/860	–58	20	244/1
TPV597	1	10.5/860	–58	9	244/1
TPV598	4	7/860	–60	5	244/1

Device	P <sub>out</sub> Output Power Watts	Class	P <sub>in</sub> (Max) Input Power Watts	G <sub>p</sub> (Min)/Freq. Power Gain dB/MHz	θ <sub>JC</sub> °C/W	Package/Style
<b>VCE = 24 Volts — Class A</b>						
MRF857S	2.1 (CW)	A	0.4	12.5/900	8.4	305D/1
MRF858	3.6 (CW)	A	0.29	11/900	6.9	319/2
MRF858S	3.6 (CW)	A	0.29	11/900	6.9	319A/2
MRF859	6.5 W (CW)	A	0.46	11.5/900	3.9	319/2
MRF859S	6.5 W (CW)	A	0.46	11.5/900	3.9	319A/2
MRF861	27 (CW)	A	8	9.5/900	0.92	375A/1
MRF862	36 (CW)	A	4.5	9/900	0.75	375A/1

<sup>(8)</sup>Vision Carrier: – 8 dB; Sound Carrier: – 7 dB; Sideband Carrier: – 16 dB

## Linear Transistors (continued)

**Table 14. UHF Ultra Linear For TV Applications (continued)**

Device	P <sub>ref</sub> (Min) Watts	G <sub>p</sub> (Min)/Freq. Small Signal Gain dB/MHz	3 Tone IMD <sup>(8)</sup> dB	θ <sub>JC</sub> °C/W	Package/Style
<b>V<sub>CC</sub> = 25 Volts, Class A</b>					
TPV695A	14	9.5/860	-47	2.5	395B/1
TPV7025	25	8.5/860	-45	1.5	398/1
TPV6030	20/35 <sup>(11)</sup>	9.5/860	-51/-	1.1	375A/1
<b>V<sub>CC</sub> = 28 Volts, Class AB</b>					
TPV8100B	100 <sup>(11)</sup>	8.5/860	—	0.7	398/1

**Table 15. Microwave Linear for PCN Applications**

The following devices have been developed for linear amplifiers in the 1.5–2 GHz region and have characteristics particularly suitable for PDC, PCS or DCS1800 base station applications.

Device	P <sub>out</sub> Watts	Class	Bias Point Vdc/ma	Gain (Typ)/Freq dB/MHz	θ <sub>JC</sub> °C/W	Package/Style
<b>V<sub>CC</sub> = 20 Volts–Bipolar Die</b>						
MRF6401 <sup>(12)</sup>	0.5	A	20/80	10/1880	30	305C/1
<b>V<sub>CC</sub> = 26 Volts–Bipolar Die</b>						
MRF6402 <sup>(13)</sup>	4.5	AB	26/40	10/1880	5	319/2
MRF6404 <sup>(16)</sup>	30	AB	26/150	8.5/1880	1.4	395C/1
MRF6408	12	AB	26/100	8.8/1880	2.8	395C/1
MRF15030	30	A, AB	26/125	9/1490	1.4	395C/1
MRF15060★	60	A, AB	26/200	10/1490	0.7	451/1
MRF15060S★	60	A, AB	26/200	10/1490	0.7	451A/1
MRF15090	90	A, AB	26/250	7.5/1490	0.7	375A/1
MRF20030 <sup>(46a)</sup>	30	A, AB	26/	—	—	395D/1
MRF20060★	60	A, AB	26/200	9/2000	0.7	451/1
MRF20060S★	60	A, AB	26/200	9/2000	0.7	451A/1
MRF20120 <sup>(46b)</sup>	120	AB	26/400	9/2000	.35	TBD
<b>V<sub>DD</sub> = 26 Volts–LDMOS Die</b>						
MRF280S <sup>(46b)</sup>	2	A, AB	26/	16/2000	10	458/1
MRF280Z <sup>(46b)</sup>	2	A, AB	26/	16/2000	10	458A/1
MRF281S <sup>(46b)</sup>	4	A, AB	26/	13.6/2000	8.75	458/1
MRF281Z <sup>(46b)</sup>	4	A, AB	26/	13.6/2000	8.75	458A/1
MRF6525–5 <sup>(46b)</sup>	5	AB	26/70	12/2000	10	458A/1
MRF6525–10 <sup>(46b)</sup>	10	AB	26/130	11/2000	6.0	458A/1
MRF282S <sup>(46a)</sup>	10	A, AB	26/75	13/2000	2.9	458/1
MRF282Z <sup>(46a)</sup>	10	A, AB	26/75	13/2000	2.9	458A/1
MRF284 <sup>(46b)</sup>	30	A, AB	26/200	11.5/2000	2.0	360B/1
MRF284S <sup>(46b)</sup>	30	A, AB	26/200	11.5/2000	2.0	360C/1
MRF286 <sup>(46b)</sup>	60	A, AB	26/500	11.4/2000	.73	465/1
MRF286S <sup>(46b)</sup>	60	A, AB	26/500	11.4/2000	.73	465A/1

**V<sub>DD</sub> = 26 Volts–LDMOS Die**

<sup>(8)</sup>Vision Carrier: -8 dB; Sound Carrier: -7 dB; Sideband Carrier: -16 dB

<sup>(11)</sup>Output power at 1 dB compression in Class AB

<sup>(12)</sup>Formerly known as "TP4001S"

<sup>(13)</sup>Formerly known as "TP4004"

<sup>(16)</sup>Formerly known as "TP4035"

<sup>(46)</sup>To be introduced: a) 1Q97; b) 2Q97; c) 3Q97; d) 3Q97; e) 4Q97

★New Product

## RF Medium Power Transistors

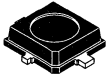
RF Medium Power Transistors are used in portable transmitter applications and low voltage drivers for higher power devices. They can be used for analog cellular, GSM and the newer digital handheld cellular phones. GaAs, LDMOS and Bipolar devices are available. RF Medium Power Transistors are supplied in industry standard SOT packages as well as Motorola's high performance PLD line of surface mount power RF packages. Other applications include talkback pagers, wireless modems and LANs, cable modems, highspeed drivers and instrumentation.



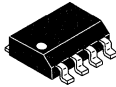
CASE 318A  
STYLE 2  
(SOT-143)



CASE 345-03  
(SOT-89)



CASE 449  
(PLD-1)



CASE 751  
(SO-8)

# RF Medium Power Transistors

## Discrete Wireless Transmitter Devices

Device	Freq. MHz	V <sub>DD</sub> V	Typical Output Power dBm	Typical Drain Eff. %	Typical Gain dB	Semiconductor Technology	Package
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### 3.5 V Applications

MRF9822T <sub>1</sub> (18f,46a)	850	3.5	31.0	70	11	GaAs PHEMT	PLD-1
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### 4.8 V Applications

MRF9242T <sub>1</sub> (18f,46b)	900	4.8	31.5	65	9.5	LDMOS	PLD-1
MRF9282T <sub>1</sub> (18f,46b)	900	4.8	34.0	60	8	LDMOS	PLD-1

### 5.8 V Applications

MXR9745T <sub>1</sub> (18f,46a)	850	5.8	31.5	60	8.5	LDMOS	SOT-89
MRF9251T <sub>1</sub> (18c,46b)	900	5.8	23.5	60	10.5	LDMOS	SOT-143
MRF9811T <sub>1</sub> (18c,46b)	900	5.8	22	60	15	GaAs MAFET	SOT-143
MRF9742(18a,b,46b)	900	5.8	30	60	11	LDMOS	SO-8
MRF9745T <sub>1</sub> (18f,46a)	900	5.8	30	55	10	LDMOS	PLD-1
MRF9762(18a,b,46b)	900	5.8	31.5	60	11	LDMOS	SO-8

(18)Tape and Reel Packaging Option Available by adding suffix: a) R1 = 500 units; b) R2 = 2,500 units; c) T1 = 3,000 units; d) T3 = 10,000 units; e) R2 = 1,500 units; f) T1 = 1,000 units.

(46)To be introduced: a) 1Q97; b) 2Q97; c) 3Q97; d) 3Q97; e) 4Q97

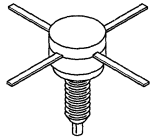
# RF Small Signal Transistors

Motorola's broad line of RF Small Signal Transistors includes NPN and PNP Silicon Bipolar Transistors characterized for low noise amplifiers, mixers, oscillators, multipliers, non-saturated switches and low-power drivers.

These devices are available in a wide variety of package types: plastic Macro-X and Macro-T, ceramic and surface mounted. Most of these transistors are fully characterized with s-parameters.



CASE 29-04  
STYLE 2  
(TO-226AA)



CASE 244A  
STYLE 1



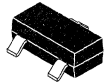
CASE 317  
STYLE 2  
(MACRO-X)



CASE 317A  
STYLE 2  
(MACRO-T)



CASE 317D  
STYLE 2  
(POWER MACRO)



CASE 318-08  
STYLE 6  
(SOT-23)



CASE 318A  
STYLE 1  
LOW PROFILE  
(SOT-143)



CASE 419  
STYLE 3, 6  
(SC-70/SOT-323)



CASE 419B  
STYLE 16, 17  
(SC-70ML/SOT-323)



CASE 751  
STYLE 1  
(SO-8)

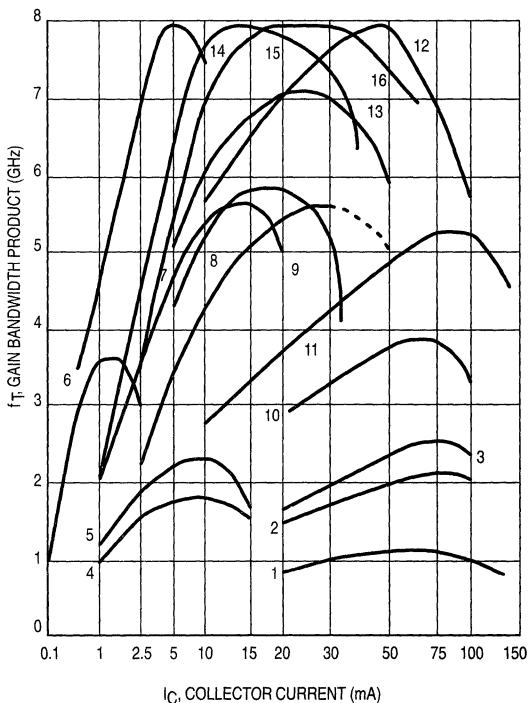
# RF Small Signal Transistors

## RF Small Signal Transistor Gain Characteristics

Curve numbers apply to transistors listed in the subsequent tables.

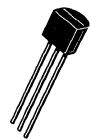
### Selection by Package

In small-signal RF applications, the package style is often determined by the end application or circuit construction technique. To aid the circuit designer in device selection, the Motorola broad range of RF small-signal amplifier transistors is organized by package. Devices for other applications such as oscillators or switches are shown in the appropriate preceding tables. **These devices are NPN polarity unless otherwise designated.**



### Plastic SOE Case

Table 1. Plastic SOE Case

Device	Gain-Bandwidth @		Curve No. Page 5.10-17	NF <sub>min</sub> @ f		Gain @ f		Maximum Ratings		Package
	f <sub>T</sub> Typ GHz	I <sub>C</sub> mA		Typ dB	MHz	Typ dB	MHz	V <sub>(BR)CEO</sub> Volts	I <sub>C</sub> mA	
<b>Case 29-04/1,2, TO-226AA</b>										
LP1001	5	10	—	2.7	500	12.5	1000	15	—	
LP1001A	5	10	—	3.2	1000	12.5	1000	15	—	
MPS911(29)	7	30	8	1.7	500	16.5	500	12	40	
MPS571	8	50	12	2	500	14	500	10	80	


(29)Packaging Options Available in Tape and Reel and Fan Fold Box

## Selection by Package (continued)


Table 1. Plastic SOE Case (continued)

Device	Gain-Bandwidth		Curve No. Page 5.10-17	NF <sub>min</sub> @ f		Gain @ f		Maximum Ratings		Package
	f <sub>T</sub> Typ GHz	I <sub>C</sub> mA		Typ dB	MHz	Typ dB	MHz	V <sub>(BR)CEO</sub> Volts	I <sub>C</sub> mA	


### Case 317/2 — MACRO-X

MRF901	4.5	15	7	2	1000	12	1000	15	30	
MRF571	8	50	12	1.5	1000	12	1000	10	70	
MRF951	8	30	16	2.1	2000	12.5	2000	10	100	
MRF559	3	100	10	—	—	13	512	18	150	
MRF581	5	75	11	2	500	15.5	500	18	200	
MRF581A	5	75	11	1.8	500	15.5	500	15	200	
MRF837	5	75	11	—	—	10	870	16	200	

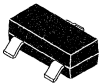
### Case 317A/2 — MACRO-T

BFR90	5	14	7	2.4	500	18	500	15	30	
BFR96	4.5	50	9	2	500	14.5	500	15	100	

### Case 317D/2

MRF553	—	—	—	—	—	13	175	16	500	
MRF555	—	—	—	—	—	12.5	470	16	400	
MRF557	—	—	—	—	—	9	870	16	400	

### Case 318-08/6 — SOT-23

MMBR521LT1(17)(18c)	3.4	-35	—	1.5	500	15	500	-10	-70	
MMBR931LT1(18c)	3	1	6	4.3	1000	10	1000	5	5	
MMBR5031LT1(18c)	1	5	—	2.5	450	17	450	10	20	
BFS17LT1(18c)	1.3	25	—	—	—	—	—	15	—	
BFR92ALT1(18c)	4.5	14	—	—	—	15	—	15	25	
MMBR901LT1(18c)	4	15	7	1.9	1000	12	1000	15	30	
BFR93ALT1(18c)	3.4	30	—	2.5	30	—	—	12	35	
MMBR920LT1(18c)	4.5	14	—	2.4	500	15	500	15	35	
MMBR5179LT1(18c)	1.4	5	4	—	—	15	200	12	50	
MMBR941LT1(18c,d)	8	15	15	2.1	2000	8.5	2000	10	50	
MMBR911LT1(18c)	6	30	8	2	500	17	500	12	60	
MMBR571LT1(18c)	8	50	12	2	500	16.5	500	10	80	
MMBR951LT1(18c)	8	30	16	2.1	2000	7.5	2000	10	100	
MMBR951ALT1(18c)	8	30	16	2.1	2000	7.5	2000	10	100	

(17)PNP

(18)Tape and Reel Packaging Option Available by adding suffix: a) R1 = 500 units; b) R2 = 2,500 units; c) T1 = 3,000 units; d) T3 = 10,000 units; e) R2 = 1,500 units;

f) T1 = 1,000 units.

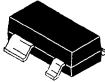


## Selection by Package (continued)


Table 1. Plastic SOE Case (continued)

Device	Gain-Bandwidth		Curve No. Page 5.10-17	NF <sub>min</sub> @ f		Gain @ f		Maximum Ratings		Package
	f <sub>T</sub> Typ GHz	I <sub>C</sub> mA		Typ dB	MHz	Typ dB	MHz	V <sub>(BR)CEO</sub> Volts	I <sub>C</sub> mA	


### Case 318A/1 — SOT-143

MRF5711LT1(18c)	8	50	12	1.6	1000	13.5	1000	10	70	
MRF5211LT1(17)(18c)	4.2	-50	—	2.8	1000	11	1000	-10	-70	
MRF9331LT1(18c)	5	1	—	2.5	1000	12.5	1000	8	2	
MRF9011LT1(18c)	3.8	15	7	2.3	1000	10.2	1000	15	30	
MRF9411LT1(18c)	8	15	15	2.1	2000	9.5	2000	10	50	
MRF9411BLT1(18c)	8	15	15	2.1	2000	9.5	2000	10	50	
MRF5811LT1(18c)★	5	75	11	2.0	500	18.4	500	18	200	
MRF9511LT1(18c)	8	30	16	2.1	2000	9	2000	10	100	
MRF9511ALT1(18c)	8	30	16	2.1	2000	9	2000	10	100	


### Case 419/3 — SC-70/SOT-323

MRF917T1(18c)★	6	20	8	2.3	1000	10	1000	12	60	
MRF577T1(18c)★	7	40	12	1.5	1000	10	1000	10	80	
MRF927T1(18c)★	8	5	14	1.7	1000	9.8	1000	10	10	
MRF947T1(18c,d)	8	15	15	2.1	2000	10.5	1500	10	50	
MRF947AT1(18c)	8	15	15	2.1	2000	10.5	1500	10	50	
MRF947BT1(18c,d)	8	15	15	2.1	2000	10.5	1500	10	50	
MRF957T1(18c)	8	30	16	2.0	2000	9	1500	10	100	


### Case 419/6 — SC-70/SOT-323

MRF947RT3(18d)	8	15	—	2.1	2000	10.5	1500	10	50	
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### Case 419B-01 — SC-70ML/SOT-363

MRF2947AT1(18c)★	8	15	15	1.5	1000	14	1000	10	50	
MRF2947RAT1(18c)★	8	15	15	1.5	1000	14	1000	10	50	

### Case 751/1 — SO-8

MRF5943(18a,b)	1.5	35	2	3.4	200	12	250	30	400	
MRF3866R2(18b)	0.8	50	1	—	—	10.5	400	30	400	
MRF4427(18b)	1.6	50	1	—	—	18	175	20	400	
MRF5812(18a,b)	5.5	75	11	2	500	15.5	500	15	200	
MRF8372R1(18a,b)	5	75	11	—	—	10	870	16	200	

(17)PNP

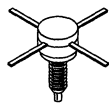
(18)Tape and Reel Packaging Option Available by adding suffix: a) R1 = 500 units; b) R2 = 2,500 units; c) T1 = 3,000 units; d) T3 = 10,000 units; e) R2 = 1,500 units; f) T1 = 1,000 units.

★New Product

## Selection by Package (continued)

### Ceramic SOE Case

Table 2. Ceramic SOE Case

Device	Gain-Bandwidth		Curve No. Page 5.10-17	N @ f		Gain @ f		Maximum Ratings		Package
	f <sub>T</sub> Typ GHz	I <sub>C</sub> mA		Typ dB	MHz	Typ dB	MHz	V <sub>(BR)</sub> CEO Volts	I <sub>C</sub> mA	
<b>Case 244A/1</b>										
MRF587	5.5	90	11	3	500	13	500	15	200	

(17)PNP






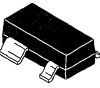

(18)Tape and Reel Packaging Option Available by adding suffix: a) R1 = 500 units; b) R2 = 2,500 units; c) T1 = 3,000 units; d) T3 = 10,000 units; e) R2 = 1,500 units; f) T1 = 1,000 units.

★New Product

# Selection by Application

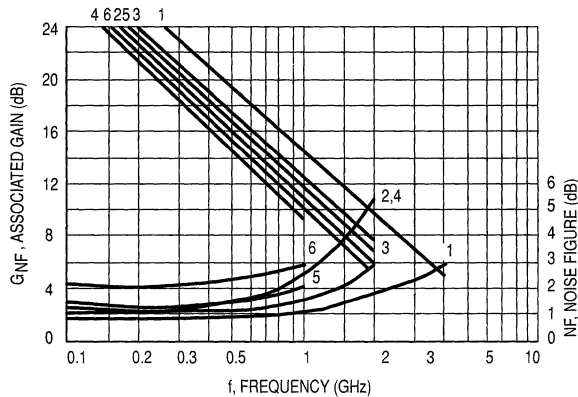
**Table 3. Low Noise**

The Small-Signal devices listed are designed for low noise and high gain amplifier mixer, and multiplier applications. Each transistor type is available in various packages. **Polarity is NPN unless otherwise noted.**

Package	Name	Case Number	Curve Number (See figure below)					
			1	2(17)	3	4	5	6
	MACRO-X	317/2	MRF951(2U)	—	MRF571	MRF581	MRF901	—
	TO-226AA	29-04/2	—	—	MPS571	—	—	MPS911
	SOT-23	318-08/6	MMBR941LT1 MMBR951LT1(20)	MMBR521LT1	MMBR571LT1	—	MMBR901LT1	MMBR911LT1
	SC-70/ SOT-323	419/3, 6	MRF917T1 MRF577T1 MRF927T1 MRF947AT1 MRF947T1 MRF947BT1 MRF947RT3 MRF957T1(20)	—	—	—	—	—
	SC-70ML/ SOT-363	419B/ 16, 17	MRF2947AT1 MRF2947RAT1	—	—	—	—	—
	SOT-143	318A/1	MRF9411BLT1 MRF9411LT1 MRF9511LT1(20) MRF9511ALT1	MRF5211LT1	MRF5711LT1	MRF5811LT1	MRF9011LT1	—
	SO-8	751/1	—	—	—	MRF5812	—	—

(17)PNP

(20)Higher Current Version



**Gain and Noise Figure versus Frequency**

## Selection by Application (continued)

**Table 4. CATV, MATV and Class A Linear**

For Class A linear CATV/MATV applications. Listed according to increasing gain bandwidth ( $f_T$ ).

Device	Nominal Test Conditions V <sub>CE/IC</sub> Volts/mA	f <sub>T</sub> Typ MHz	Noise Figure	Distortion Specifications				V <sub>(BR)CEO</sub> V	Package/ Style
			Typ/Freq. dB/MHz	2nd Order IMD dBc	3rd Order IMD dBc	12 Ch. Cross- Mod. dBc	Output Level dBmV		
MMBR5179LT1(18c)	6/5	1500	4/450					12	318-08/6
MRF5943(18a,b)	15/50	1500	3.4/200					30	751/1
MMBR5031LT1(18c,d)	6/5	2000	1.9/450					10	318-08/6
MMBR920LT1(18c,d)	10/14	4500	2.4/500					15	318-08/6
BFR96	10/50	4500	2/500					15	317A/2
BFR90	10/14	5000	2.4/500					15	317A/2
MRF581	10/75	5000	2.7/300		-65		+50	18	317/2
MRF581A	10/75	5000	1.8/500		-65		+50	15	317/2
MRF5812(18a,b)	10/75	5000	1.8/500		-65		+50	15	751/1
LP1001		5000	2.7/500					15	29-04/2
LP1001A		5000	3.2/1000					15	29-04/2
MRF587	15/90	5500	3/500	-52	-72		+50	17	244A/1

(18) Tape and Reel Packaging Option Available by adding suffix: a) R1 = 500 units; b) R2 = 2,500 units; c) T1 = 3,000 units; d) T3 = 10,000 units; e) R2 = 1,500 units; f) T1 = 1,000 units.

# Monolithic Integrated Circuits

Motorola's RF monolithic integrated circuit devices provide an integrated solution for the personal communications market. These devices are available in plastic SOIC-8, SOIC-16, SOT-143, TSSOP-16, TSSOP-16HS, TSSOP-20, TSSOP-20HS, TQFP-48 or PFP-16 packages.

## Evaluation Boards

Evaluation boards are available for RF Monolithic Integrated Circuits by adding a "TF" suffix to the device type. For a complete list of currently available boards and ones in development for newly introduced product, please contact your local Motorola Distributor or Sales Office.



CASE 318A-05  
(SOT-143)



CASE 751  
(SO-8)



CASE 751B  
(SO-16)



CASE 846A  
(MICRO-8)



CASE 932  
(TQFP-48)



CASE 948C  
(TSSOP-16)



CASE 948D  
(TSSOP-20)



CASE 978  
(PFP-16)

# RF Monolithic Integrated Circuits

## Switching

### Antenna Switches/Local Oscillator Switches

Device	Freq. Range MHz	Supply Volt. Range Vdc	Supply Current $\mu$ A (Typ)	P <sub>in</sub> , 1 dB Compression dBm (Typ)	TX Insertion Loss dB (Typ)	Isolation dB (Typ)	Package	System Applicability
MRFIC2003(18b)	100–1000	2.8–6.0	< 10	21	0.5	20	SO–8	CT2, ISM
MRFIC1801(18b)	1500–2500	2.7–5.5	300	29	0.6	20	SO–8	DECT, PHS, PCS, ISM
MRFIC0903(18b)★	100–2000	2.7–5.0	60	35.5	0.65	21	SO–8	AMPS, Class 4 & 5 GSM, DCS1800, PHS, PCS
MRFIC0921(46b)	100–1000	2.7–5.5	300	16	0.6	22	Micro–8	AMPS, CT1, CT2, GSM, IS–54, ISM, DECT, PHS, PCS

## Receiver Functions

### General Purpose Integrated Circuits

#### General Purpose Cascode Amplifier

Device	Freq. Range MHz	Supply Volt. Range Vdc	Supply Current mA (Typ)	Small Signal Gain @ 900 MHz dB (Typ)	Noise Figure dB (Typ)	Reverse Isolation dB (Typ)	Package	System Applicability
MRFIC0915(18c,46b)	100–2000	2.7–5.0	2.2	16.5	1.9	38	SOT–143	AMPS, CT1, CT2, GSM, IS–54, ISM, DECT, PHS, PCS
MRFIC0916(18c)★	100–2000	2.7–5.0	4.7	18.5	1.9	44	SOT–143	AMPS, CT1, CT2, GSM, IS–54, ISM, DECT, PHS, PCS

## 900 MHz Front End

#### LNA + Mixer

Device	RF Freq. Range MHz	IF Freq. Range MHz	Supply Volt. Range Vdc	Supply Current mA (Typ)	Conv. Gain dB (Typ)	Output Level, 1 dB Comp. dBm (Typ)	Package	System Applicability
MRFIC2001(18b)	500–1000	0–250	2.7–5.0	4.7	23	–10	SO–8	CT2, ISM

## 1.5 – 2.2 GHz Front End

#### Integrated LNA

Device	Freq. Range MHz	Supply Volt. Range Vdc	Supply Current mA (Typ)	Small Signal Gain dB (Typ)	Noise Figure dB (Typ)	Reverse Isolation dB (Typ)	Package	System Applicability
MRFIC1501(18b)★	1000–2000	3–5	5.7	18	1.1	26	SO–8	DECT, PHS, PCS
MRFIC1808(18b)★	1700–2100	2.7–4.5	4.2	17	1.6	37	SO–8	DECT, PHS, PCS

#### GPS Receiver

MRFIC1502(46a)	1570–1580	4.5–5.5	50	65	9.5	—	TQFP–48	GPS
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(18)Tape and Reel Packaging Option Available by adding suffix: a) R1 = 500 units; b) R2 = 2,500 units; c) T1 = 3,000 units; d) T3 = 10,000 units; e) R2 = 1,500 units;

f) T1 = 1,000 units.

(46)To be introduced: a) 1Q97; b) 2Q97; c) 3Q97; d) 3Q97; e) 4Q97

★New Product

## Receiver Functions: 1.5 – 2.2 GHz Front End (continued)

### Integrated LNA/Downconverter

Device	RF Freq. Range GHz	IF Freq. Range GHz	Supply Volt. Range Vdc	Supply Current RX Mode mA (Typ)	Mixer Conv. Gain dB (Typ)	LNA Gain dB (Typ)	LNA Noise Figure dB (Typ)	Package	System Applicability
MRFIC1804(18b)	1.8–2.0	70–325	2.7–3.3	10	4	14	2.3	SO–16	DECT,PHS,PCS
MRFIC1814(18b,46a)	1.8–2.0	70–300	2.7–4.5	10	9	17	2.5	TSSOP–16	DECT,PHS,PCS

## 2.4 GHz Front End

### Integrated LNA/Downconverter

Device	RF Freq. Range MHz	IF Freq. Range MHz	Supply Volt. Range Vdc	Supply Current mA (Typ)	Conv. Gain dB (Typ)	LNA Noise Figure dB (Typ)	Isolation Lo to RF, Lo to IF dB (Typ)	Package	System Applicability
MRFIC2401(18b)	2400–2500	100–350	4.75–5.25	9.5	21	1.9	20	SO–16	WLAN, MMDS, ISM

## Transmitter Functions

### General Purpose Integrated Circuits

#### Quadrature Modulator

Device	Freq. Range MHz	Supply Volt. Range Vdc	Supply Current mA (Typ)	Gain Control dB (Typ)	Lo Leakage dBm (Typ)	SSB P <sub>out</sub> , 1 dB Compression dBm (Typ)	Package	System Applicability
MRFIC0001(18b)	50–260	2.7–5.5	10	30	–55	–10	TSSOP–20	DCS1800, GSM, NADC PDC, PHS

#### General Purpose Cascode Amplifier

Device	Freq. Range MHz	Supply Volt. Range Vdc	Supply Current mA (Typ)	Small Signal Gain @ 900 MHz dB (Typ)	Noise Figure dB (Typ)	Reverse Isolation dB (Typ)	Package	System Applicability
MRFIC0915(18c,46a)	100–2000	2.7–5.0	2.2	16.5	1.9	38	SOT–143	AMPS,CT1,CT2,GSM,IS–54, ISM,DECT,PHS,PCS
MRFIC0916(18c)★	100–2000	2.7–5.0	4.7	18.5	1.9	44	SOT–143	AMPS,CT1,CT2,GSM,IS–54, ISM,DECT,PHS,PCS

(18)Tape and Reel Packaging Option Available by adding suffix: a) R1 = 500 units; b) R2 = 2,500 units; c) T1 = 3,000 units; d) T3 = 10,000 units; e) R2 = 1,500 units;

f) T1 = 1,000 units.

(46)To be introduced: a) 1Q97; b) 2Q97; c) 3Q97; d) 3Q97; e) 4Q97

★New Product

## Transmitter Functions (continued)

### 900 MHz Transmit Chain

#### Transmit Mixer

Device	RF Freq. Range MHz	IF Freq. Range MHz	Supply Volt. Range Vdc	Supply Current mA (Typ)	Standby Current $\mu$ A (Typ)	Conv. Gain dB (Typ)	Output Level, 1 dB Comp. dBm (Typ)	Package	System Applicability
MRFIC2002 <sup>(18b)</sup>	500–1000	0–250	2.7–5.0	5.5	0.1	10	–18	SO–8	AMPS,CT1,CT2, GSM, IS–54, ISM
MRFIC2101 <sup>(18b)</sup>	800–1000	0–250	3–4.75	45	2	26.5	4.5	SO–16	AMPS,CT1,CT2, GSM, IS–54, ISM
MRFIC0931 <sup>(18b, 46a)</sup>	500–2000	0–250	2.7–4.5	38	—	—	—	SO–8	AMPS,CT1,CT2, GSM, IS–54, ISM, USPCS, CDMA

#### Driver Amplifier

Device	Freq. Range MHz	Supply Volt. Range Vdc	Supply Current mA (Typ)	Standby Current mA (Typ)	Small Signal Gain dB (Typ)	Gain Control dB (Typ)	P <sub>out</sub> , 1 dB Compression dBm (Typ)	Package	System Applicability
MRFIC2004 <sup>(18b)</sup>	800–1000	2.7–4.0	11	0.7	21.5	34	–1	SO–16	AMPS,CT1,CT2, GSM,ISM
MRFIC2006 <sup>(18b)</sup>	500–1000	1.8–4.0	46	—	23	—	15.5	SO–8	AMPS,CT1,CT2, GSM,ISM
MRFIC0904 <sup>(18b)</sup> ★	800–1000	2.7–5.0 <sup>(47)</sup>	280	0.05	27	24.5	25.5	SO–16	AMPS,GSM,ISM

### Integrated Power Amplifiers

#### Low Power 900 MHz Power Amplifiers

Device	Freq. Range MHz	Supply Volt. Range Vdc	Supply Current mA (Typ)	Small Signal Gain dB (Typ)	Return Loss Input/Output dB (Typ)	P <sub>out</sub> , 1 dB Compression dBm (Typ)	Package	Semiconductor Technology
MRFIC2006 <sup>(18b)</sup>	500–1000	1.8–4.0	46	23	15	15.5	SO–8	Silicon

Device	Freq. Range MHz	Supply Volt. Range Vdc	Supply Current mA (Typ)	Standby Current mA (Typ)	Small Signal Gain dB (Typ)	P <sub>out</sub> , 1 dB Compression dBm (Typ)	Package	Semiconductor Technology
MRFIC2101 <sup>(18b)</sup>	800–1000	3–4.75	38	2	16	18	SO–16	Silicon

#### Analog Cellular

Device	Freq. Range MHz	Supply Volt. Vdc	Power Added Efficiency % (Min)	Power Gain dB (Min)	Harmonic Output 2fo dBc	P <sub>out</sub> /P <sub>in</sub> dBm (Min)	Package	Semiconductor Technology
MRFIC0910 <sup>(18e,46a)</sup>	824–905	4.8	50	17.8	–40	30.8/13	PFP–16	LDMOS
MRFIC0912 <sup>(18e)</sup> ★	824–905	4.6 <sup>(47)</sup>	55	23.8	–25	30.8/7	PFP–16	GaAs
MRFIC0923 <sup>(18e,46c)</sup>	824–905	3.6	50	17.8	–40	30.8/13	PFP–16	LDMOS

<sup>(18)</sup>Tape and Reel Packaging Option Available by adding suffix: a) R1 = 500 units; b) R2 = 2,500 units; c) T1 = 3,000 units; d) T3 = 10,000 units; e) R2 = 1,500 units; f) T1 = 1,000 units.

<sup>(46)</sup>To be introduced: a) 1Q97; b) 2Q97; c) 3Q97; d) 3Q97; e) 4Q97

<sup>(47)</sup>Negative supply required

★New Product



## Transmitter Functions: 900 MHz Transmit Chain: Integrated Power Amplifiers (continued)

### GSM Cellular

Device	Freq. Range MHz	Supply Volt. Vdc	Power Added Efficiency % (Min)	Power Gain dB (Min)	Harmonic Output 2fo dBc	P <sub>out</sub> /P <sub>in</sub> dBm (Min)	Package	Semiconductor Technology
MRFIC0913(18e)★	880–915	4.8(47)	48	24.5	–30	34.5/10	PFP–16	GaAs
MRFIC0917(18e,46c)	880–915	3.6(47)	45	24.5	–30	34.5/10	PFP–16	GaAs

### DCS1800, PCS1900

Device	Freq. Range MHz	Supply Volt. Vdc	Power Added Efficiency % (Min)	Power Gain dB (Min)	Harmonic Output 2fo dBc	P <sub>out</sub> /P <sub>in</sub> dBm (Min)	Package	Semiconductor Technology
MRFIC1818(18e,46a)	1.7–1.9	4.8(47)	35	30	–30	33/3	PFP–16	GaAs
MRFIC1817(18e,46d)	1.7–1.9	3.6(47)	35	27	–30	32/5	PFP–16	GaAs

### Two-way Paging, ISM

Device	Freq. Range MHz	Supply Volt. Vdc	Power Added Efficiency % (Min)	Power Gain dB (Min)	Harmonic Output 2fo dBc	P <sub>out</sub> /P <sub>in</sub> (Typ)	Package	Semiconductor Technology
MRFIC0914(18b)★	890–950	4.8	40	28	–45	30.5/2.5	SO–16	LDMOS
MRFIC0920(18b, 46b)	890–950	3.4	40	27.5	–45	30.5/3	TSSOP–16HS	LDMOS

## 1.5 – 2.2 GHz Transmit Chain

### Upconverter

Device	RF Output Freq. Range GHz	Supply Volt. Range Vdc	Supply Current TX Mode mA (Typ)	Standby Current $\mu$ A (Typ)	Conv. Gain dB (Typ)	Recommended IF Input MHz (Typ)	P <sub>out</sub> , 1 dB Comp. dBm (Typ)	Package	System Applicability
MRFIC1803(18b)	1.7–2.5	2.7–3.3	28	100	10	70–350	–2	SO–16	DECT,PHS, PCS
MRFIC1813(18b)★	1.7–2.5	2.7–4.5	25	100	15	70–350	3	TSSOP–16	DECT,PHS, PCS

### Power Amplifier

Device	RF Output Freq. Range GHz	Supply Volt. Range Vdc(47)	Supply Current mA (Typ)	Standby Current mA (Typ)	Small Signal Gain dB (Typ)	P <sub>out</sub> /P <sub>in</sub> dBm (Typ)	1 dB Comp. dBm (Typ)	Pkg	System Applicability
MRFIC1805(18b, 46a)	1.7–2.5	2.7–5.0	190	0.25	21	22/0	23	TSSOP–16	DECT,PHS, PCS
MRFIC1806(18b)	1.5–2.5	3.0–5.0	115	0.25	23	19.5/–3	21	SO–16	DECT,PHS, PCS
MRFIC1807(18b)	1.5–2.2	3.0–5.0	325	0.06	8	26.8/20	25	SO–16	DECT,PHS, PCS

(18)Tape and Reel Packaging Option Available by adding suffix: a) R1 = 500 units; b) R2 = 2,500 units; c) T1 = 3,000 units; d) T3 = 10,000 units; e) R2 = 1,500 units;

f) T1 = 1,000 units.

(46)To be introduced: a) 1Q97; b) 2Q97; c) 3Q97; d) 3Q97; e) 4Q97

(47)Negative supply required

★New Product

## Transmitter Functions: 1.5 – 2.2 GHz Transmit Chain (continued)

### Power Amplifier

Device	RF Output Freq. Range GHz	Supply Volt. Range Vdc	PA Supply Current TX Mode mA (Typ)	Standby Current mA (Typ)	Small Signal Gain dB (Typ)	Insertion Loss Rx Mode dB (Typ)	P <sub>out</sub> , 1 dB Compression dBm (Typ)	Package	System Applicability
MRFC1807(18b) (Including TX/RX Switch)	1.5–2.2	3.0–5.0	325	0.06	8	1	25	SO–16	DECT, PHS, PCS

## 2.4 GHz Transmit Chain

### Exciter Amplifier

Device	Freq. Range GHz	Supply Volt. Range Vdc	Supply Current mA (Typ)	Small Signal Gain dB (Typ)	Noise Figure dB (Typ)	P <sub>out</sub> , 1 dB Compression dBm (Typ)	Package	System Applicability
MRFC2404(18b)	2.0–3.0	4.75–5.25	9	17	4.3	5	SO–8	WLAN, MMDS, ISM

### Power Amplifier

Device	Freq. Range MHz	Supply Volt. Range Vdc	Supply Current mA (Typ)	Small Signal Gain dB (Typ)	Power Control Range dB (Typ)	P <sub>out</sub> , 1 dB Compression dBm (Typ)	Package	System Applicability
MRFC2403(18b)	2200–2700	4.75–5.25	95	23	20	19	SO–16	WLAN, MMDS, ISM
MRFC2410(46b)	2200–2700	4.75–5.25	400	17.5	—	31.5	TSSOP–20HS	WLAN, MMDS, ISM

### Upconverter

Device	RF Output Freq. Range GHz	Supply Volt. Range Vdc	Supply Current TX Mode mA (Typ)	Standby Current $\mu$ A (Typ)	Conv. Gain dB (Typ)	Recommended IF Input MHz (Typ)	P <sub>out</sub> , 1 dB Comp. dBm (Typ)	Package	System Applicability
MRFC1803(18b)	1.7–2.5	2.7–3.3	28	100	10	70–350	–2	SO–16	WLAN, ISM
MRFC1813(18b)★	1.7–2.5	2.7–4.5	25	100	15	70–350	3	TSSOP–16	WLAN, ISM
MRFC2406(18b,46a)	2.4–2.5	3–5	15	.6	6	100–370	–10	SO–16	WLAN, MMDS, ISM

(18) Tape and Reel Packaging Option Available by adding suffix: a) R1 = 500 units; b) R2 = 2,500 units; c) T1 = 3,000 units; d) T3 = 10,000 units; e) R2 = 1,500 units; f) T1 = 1,000 units.

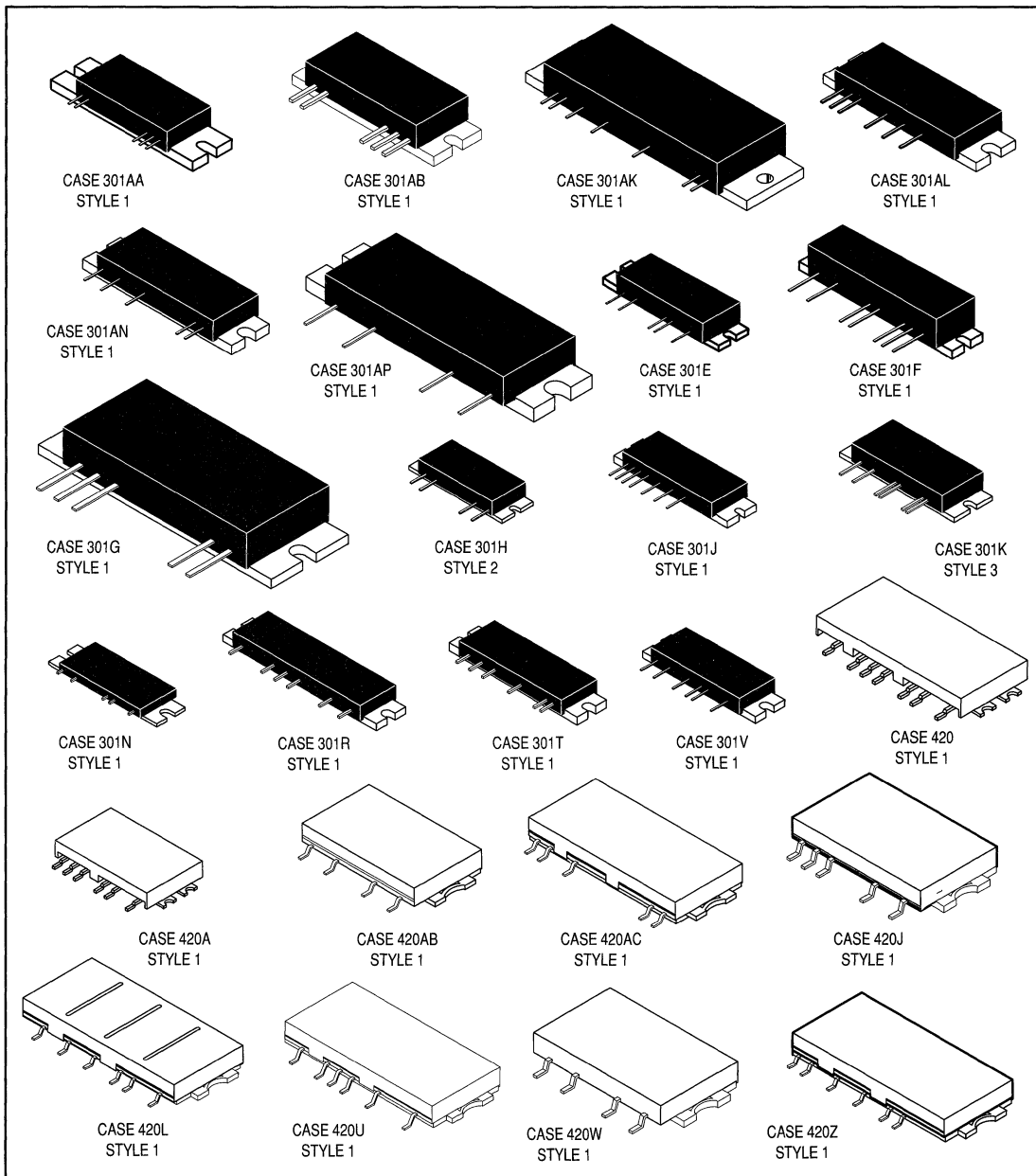
(46) To be introduced: a) 1Q97; b) 2Q97; c) 3Q97; d) 3Q97; e) 4Q97

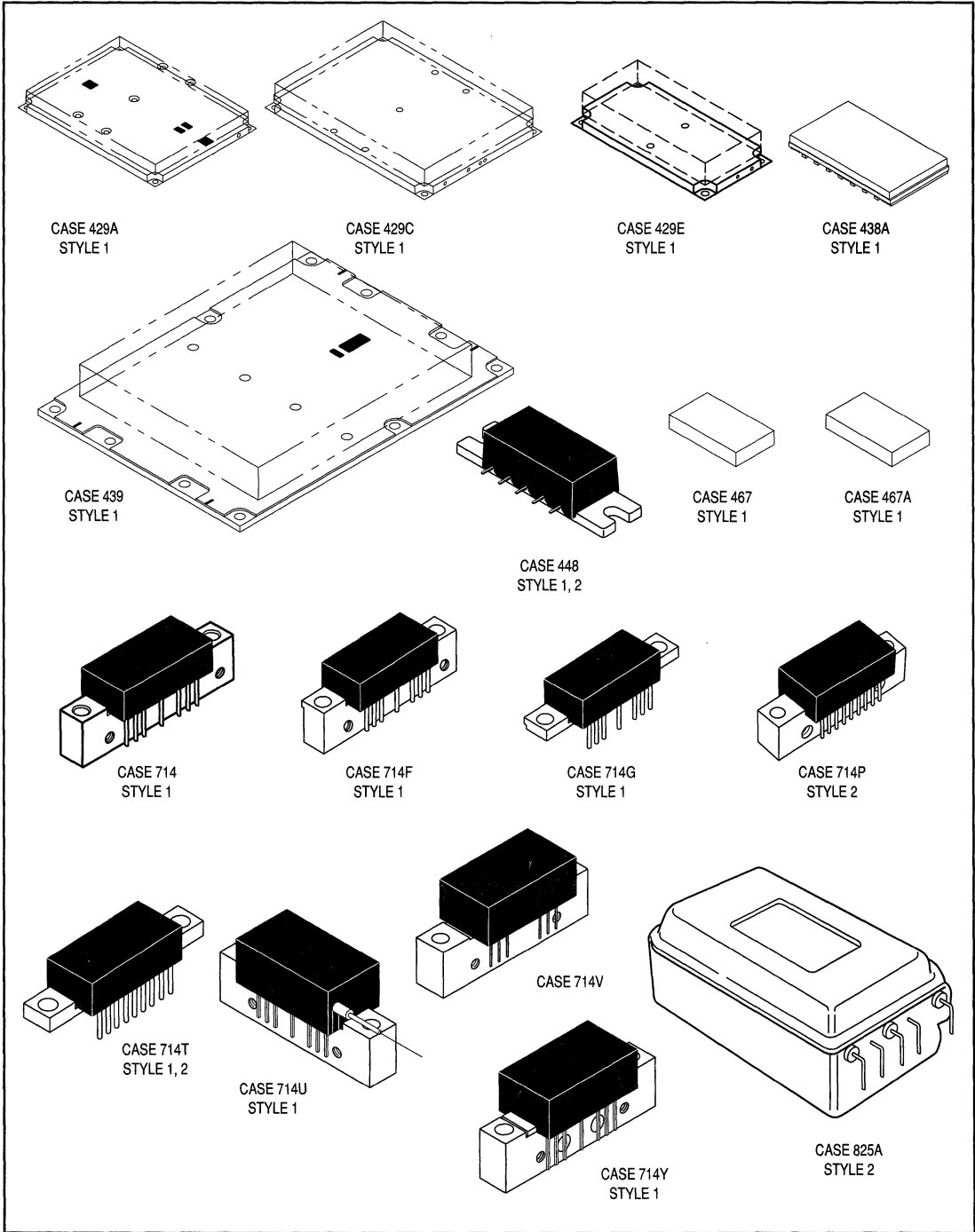
★New Product

# RF Amplifiers

Motorola's line of RF amplifiers designed and specified for use in land mobile radios, CATV distribution systems and general purpose wideband amplification applications. They feature small size, matched inputs and outputs, high stability and guaranteed performance specifications. For the user, they offer the benefits of smaller and less complex system designs in less time and at lower overall cost.

Each amplifier uses modern transistor chips which are gold metallized and have silicon nitride passivation for increased reliability and long life. Chip and wire construction features MOS capacitors and laser trimmed nichrome resistors. Circuit substrates and metallization have been selected for optimum performance cost and reliability.





# RF Amplifier Modules

Complete amplifiers with 50 ohm in/out impedances are available for a variety of applications including land mobile radios, base stations, TV transmitters and other uses requiring large-signal amplification, both linear and Class C. Frequencies covered range from 68–1990 MHz with power levels extending to 180 watts.

## Land Mobile/Portable

The advantages of small size, reproducibility and overall lower cost become more pronounced with increasing frequency of operation. These amplifiers offer a wide range in power levels and gain, with guaranteed performance specifications for bandwidth, stability and ruggedness.

**Table 1. VHF/UHF, Class C**

Device	P <sub>out</sub> Output Power Watts	P <sub>in</sub> Input Power Watts	f Frequency MHz	G <sub>p</sub> Power Gain, Min dB	V <sub>CC</sub> Supply Voltage Volts	Package/Style
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### 68–210 MHz, VHF Band — Class C (Silicon Bipolar Die)

MHW105	5	0.001	68–88	37	7.5	301K/3
MHW607–1	7	0.001	136–150	38.4	7.5	301K/3
MHW607–2	7	0.001	146–174	38.4	7.5	301K/3
MHW607–3	7	0.001	174–195	38.4	7.5	301K/3
MHW607–4	7	0.001	184–210	38.4	7.5	301K/3

### 136–174 MHz, VHF Band — (LDMOS Die)

Device	P <sub>out</sub> Output Power Watts	P <sub>in</sub> Input Power Watts	f Frequency MHz	G <sub>p</sub> Power Gain, Min dB	V <sub>DD</sub> Supply Voltage Volts	Package/Style
MHW2607–1(46a)	7	0.001	136–174	38.5	7.5	301AN/1
MHW2627–1(46a)	7	0.02	136–174	25.5	7.5	420AC/1
MHW2627–2(46a)	7	0.02	216–234	25.5	7.5	420AC/1

### 380–470 MHz, Land Mobile Linear (for TransEuropean Trunked Radio – TETRA) — Class AB — (LDMOS Die)

Device	P <sub>sat</sub> Watts	ACP (P <sub>out</sub> = 1.6 W @ f <sub>o</sub> ± 25 kHz, 18 kHz BW) (dBc)	f Frequency MHz	G <sub>p</sub> Power Gain, Min dB	V <sub>DD</sub> Supply Voltage Volts	Package/Style
MHW2701–1(46a)	4.5	–30	380–430	28	7	420Z/1
MHW2701–2(46a)	4.5	–30	420–470	28	7	420Z/1

### 380–470 MHz, Land Mobile Linear (for TransEuropean Trunked Radio – TETRA) — Class AB — (LDMOS Die)

Device	P <sub>sat</sub> Watts	ACP (P <sub>out</sub> = 5 W @ f <sub>o</sub> ± 25 kHz, 18 kHz BW) (dBc)	f Frequency MHz	G <sub>p</sub> Power Gain, Min dB	V <sub>DD</sub> Supply Voltage Volts	Package/Style
MHW2703(46a)	10	–30	380–400	28	7	420Z/1
MHW2723(46a)	12	–30	380–470	30	12.5	420Z/1

### 400–512 MHz, UHF Band — Class C (Silicon Bipolar Die)

Device	P <sub>out</sub> Output Power Watts	P <sub>in</sub> Input Power Watts	f Frequency MHz	G <sub>p</sub> Power Gain, Min dB	V <sub>CC</sub> Supply Voltage Volts	Package/Style
MHW704–1	3	0.001	400–440	34.8	6.0	301J/1
MHW704–2	3	0.001	440–470	34.8	6.0	301J/1
MHW707–1	7	0.001	403–440	38.4	7.5	301J/1
MHW707–2	7	0.001	440–470	38.4	7.5	301J/1
MHW707–3	7	0.001	470–500	38.4	7.5	301J/1
MHW707–4	7(23)	0.001	490–512	38.4(23)	7.5	301J/1

(23)P<sub>o</sub> @ f = 490 MHz. P<sub>o</sub> = 6.5 W @ f = 512 MHz

(46)To be introduced: a) 1Q97; b) 2Q97; c) 3Q97; d) 3Q97; e) 4Q97

## Land Mobile/Portable (continued)

### 400–512 MHz, UHF Band — Class C (Silicon Bipolar Die) – continued

Device	P <sub>out</sub> Output Power Watts	P <sub>in</sub> Input Power Watts	f Frequency MHz	G <sub>p</sub> Power Gain, Min dB	V <sub>CC</sub> Supply Voltage Volts	Package/Style
MHW720A1(22)	20	0.15	400 – 440	21	12.5	700/2
MHW720A2(22)	20	0.15	440 – 470	21	12.5	700/2

### 400–520 MHz, UHF Band — Class D – A (Dynamic Bias via Gate Control) — (LDMOS Die)

Device	P <sub>out</sub> Output Power Watts	P <sub>in</sub> Input Power Watts	f Frequency MHz	G <sub>p</sub> Power Gain, Min dB	V <sub>DD</sub> Supply Voltage Volts	Package/Style
MHW2707-1 ★	7	0.001	400–440	38.5	7.5	301AL/1
MHW2707-2 ★	7	0.001	440–470	38.5	7.5	301AL/1
MHW2707A-1 (46a)	7	0.001	400–470	38.5	7.5	301AL/1
MHW2707A-2 (46a)	7	0.001	470–520	38.5	7.5	301AL/1
MHW2717-1 (46a)	7	0.02	400–470	25.5	7.5	420J/1
MHW2717-2 (46a)	7	0.02	450–520	25.5	7.5	420J/1
MHW2727-1 (46a)	7	0.02	400–470	25.5	7.5	420AC/1
MHW2727-2 (46a)	7	0.02	450–520	25.5	7.5	420AC/1

### 806–821 MHz, UHF Band (for Integrated Digital Enhanced Network – iDEN™)— Class AB — (LDMOS Die)

MHW2801 (46a)	0.8	0.00025	806–821	35	6	420L/1
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### 806–960 MHz, UHF Band — Class C (Silicon Bipolar Die)

Device	P <sub>out</sub> Output Power Watts	P <sub>in</sub> Input Power Watts	f Frequency MHz	G <sub>p</sub> Power Gain, Min dB	V <sub>CC</sub> Supply Voltage Volts	Package/Style
MHW851-1	1.6	0.001	820–850	32	6	301N/1
MHW851-2	1.6	0.001	870–905	32	6	301N/1
MHW851-3	2	0.001	890–915	33	6	301N/1
MHW851-4	1.6	0.001	915–925	32	6	301N/1
MHW803-1	2	0.001	820–850	33	7.5	301E/1
MHW803-2	2	0.001	806–870	33	7.5	301E/1
MHW803-3	2	0.001	870–905	33	7.5	301E/1
MHW804-1	4	0.001	800–870	36	7.5	301F/1
MHW806A4(22)	6	0.04	870–950	21.7	12.5	301H/2

### 806 – 960 MHz, UHF Band — Class AB (LDMOS Die)

Device	P <sub>out</sub> Output Power Watts	P <sub>in</sub> Input Power Watts	f Frequency MHz	G <sub>p</sub> Power Gain, Min dB	V <sub>DD</sub> Supply Voltage Volts	Package/Style
MHW2803 (46a)	3.5	0.001	806–824	35.5	6	420L/1
MHW2805-1 (46a)	5	0.004	806–870	31	7.5	420AB/1
MHW2805-2 (46a)	5	0.004	890–950	31	7.5	420AB/1
MHW2820-1 (46a)	20	<0.250	806–870	19	12.5	301G/1(42)
MHW2820-2 (46a)	18	<0.300	890–950	17.9	12.5	301G/1(42)
MHW2821-1★	20	<0.250	806–870	19	12.5	301AB/1
MHW2821-2★	18	<0.300	890–950	17.9	12.5	301AB/1

### 1710 – 1785 MHz, UHF Band — (GaAs FET Die)

Device	P <sub>out</sub> Output Power Watts	P <sub>in</sub> Input Power Watts	f Frequency MHz	G <sub>p</sub> Power Gain, Min dB	V <sub>CC</sub> Supply Voltage Volts	Package/Style
MHW9014	2.1	0.001	1710–1785	33.2	6.0	420/1

(22) Designed for Wide Range P<sub>out</sub> Level Control

(42) Drop-in for bipolar MHW820

(46) To be introduced: a) 1Q97; b) 2Q97; c) 3Q97; d) 3Q97; e) 4Q97

★New Product

**Table 2. UHF, Linear**

Device	P <sub>out</sub> Output Power Watts	P <sub>in</sub> Input Power Watts	f Frequency MHz	G <sub>p</sub> Power Gain, Min dB	V <sub>CC</sub> Supply Voltage Volts	Package/Style
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**800 MHz, (for CDMA and TDMA, Dual Mode) — (GaAs)**

MHW9005(46b)	1	0.004	824–849	24	5.8	438A/1
MHW9006(46b)	1.4/0.63(43)	0.004	824–849	25.5/22	5.8	438A/1

**824–849 MHz, UHF Band — Class AB (Silicon Bipolar Die)**

MHW920★	0.8(24)	0.001	824–849	29	6	420U/1
MHW927B(22)	6(24)	0.001	824–849	37.8	12.5	301AA/1

**880–960 MHz (for GSM) — Class AB (Silicon Bipolar Die)**

MHW953(22)	3.5	0.001	890–915	35.4	7.2	301V/1
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**880–960 MHz (for GSM) — Class AB (LDMOS Silicon FET)**

Device	P <sub>out</sub> Output Power Watts	P <sub>in</sub> Input Power Watts	f Frequency MHz	G <sub>p</sub> Power Gain, Min dB	V <sub>DD</sub> Supply Voltage Volts	Package/Style
MIM2901 (46a)	1.41	0.004	824–849	25.5	3.6	TBD
MIM2906 (46a)	3.5	0.002	890–915	32.5	6	467A/1
MIM2908 (46a)	3.2	0.002	880–915	32	4.8	467/1
MHW2905★	3.2	0.002	890–915	32	6	420W/1
MHW910 (46a)	10	0.050	925–960	23	24	301AB/1
MHW913	14	0.1	880–915	21.5	12.5	301AB/1
MHW914(22)	14	0.001	890–915	41.4	12.5	301R/1
MHW916	16	0.036	925–960	26.5	26	301AB/1
MHW930 (46a)	30	0.050	925–960	27	26	301AB/1

**1805–1880 MHz (for DCS1800) — Class AB (Silicon Bipolar Die)**

Device	P <sub>out</sub> Output Power Watts	P <sub>in</sub> Input Power Watts	f Frequency MHz	G <sub>p</sub> Power Gain, Min dB	V <sub>CC</sub> Supply Voltage Volts	Package/Style
MHW1815★	14.5	0.005	1805–1880	34.6	26	301AK/1

**1930–1990 MHz (for PCS1900) — Class AB (Silicon Bipolar Die)**

MHW1916★	15.0	0.005	1930–1990	34.8	26	301AK/1
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(22)Designed for Wide Range P<sub>out</sub> Level Control

(24)Average Power; Peak Power is twice average power

(43)Capacitive Load 8.5 pF, V<sub>out</sub> = 40 V P-P

(46)To be introduced: a) 1Q97; b) 2Q97; c) 3Q97; d) 3Q97; e) 4Q97

★New Product

# Wideband Linear Amplifiers

**Table 1. General Purpose Wideband Amplifiers**

Device	Frequency Range MHz	Gain Min/Typ dB	Supply Voltage Vdc	Output Level 1 dB Compression MW/@ MHz	Noise Figure @ 250 MHz dB	Package/ Style
<b>50–100 Ω Hybrids</b>						
MHW591	1 – 250	34.5/36.5	13.6	700/100	5	714/1
MHW592	1 – 250	33.5/35	24	900/100	5	714/1
MHW593	10 – 400	33/34.5	13.6	600/200	5	714/1
MHW590	10 – 400	31.5/34	24	800/200	5	714/1

**Table 2. Cellular Base Station Pre-Drivers**

These 50 ohm amplifiers are recommended for modern, multi-tone, CDMA and/or TDMA base-station pre-driver applications. Their high third-order intercept, tight phase control and excellent group delay characteristics make these amplifiers ideal for use in high-power feedforward loops.

**Ultra-Linear – Class A (Silicon Bipolar Die)**

Device	BW MHz	V <sub>CC</sub> (Nom.) Volts	I <sub>CC</sub> (Nom.) mA	Gain (Nom.) dB	Gain Flatness (Typ) ±dB	P <sub>1dB</sub> (Typ) dBm	3rd Order Intercept (Typ) dBm/MHz	NF (Typ) dB	Case/ Style
MHL9125★	800–960	15	700	20	0.5	31	43	7.5	448/2
MHL9128★	800–960	28	400	20	0.5	31	43	7.5	448/1

**Ultra-Linear – Class A (LDMOS Die)**

Device	BW MHz	V <sub>DD</sub> (Nom.) Volts	I <sub>DD</sub> (Nom.) mA	Gain (Nom.) dB	Gain Flatness (Typ) ±dB	P <sub>1dB</sub> (Typ) dBm	3rd Order Intercept (Typ) dBm/MHz	NF (Typ) dB	Case/ Style
MHL9236 (46b)	800–960	26	525	30	.1	34	47	4.5	301AP/1
MHL9232 (46c)	800–960	12.5	700	30	.1	34	47	5.0	301AP/1

**Table 3. Standard 50 Ohm Linear Hybrids**

This series of RF linear hybrid amplifiers have been optimized for wideband, 50 ohm applications. These amplifiers were designed for multi-purpose RF applications where linearity, dynamic range and wide bandwidth are of primary concern. Each amplifier is available in various package options. The MHL series utilizes a new case style that provides microstrip input and output connections.

Device	BW MHz	V <sub>CC</sub> (Nom.) Volts	I <sub>CC</sub> (Nom.) mA	Gain/Freq. (Typ) dB/MHz	Gain Flatness (Typ) ±dB	P <sub>1dB</sub> (Typ) dBm	3rd Order Intercept Point/Freq. (Typ) dBm/MHz	NF/Freq. (Typ) dB/MHz	Case/ Style
CA2832C	1–200	28	435	35.5/100	0.5	33	47/200	5/200	714F/1
CA2830C	5–200	24	300	34.5/100	0.5	29	46/200	4.7/200	714F/1
CA2833C	5–200	24	300	34.5/100	0.5	29	46/200	4.7/200	714G/1
CA2818C	.35–400	24	205	18.5/50	0.5	30	45/200	5/200	714F/1
CA2842C	10–400	24	230	22/100	0.5	30	44/300	4/100	714F/1
CA2810C	10–450	24	310	34/50	1.5	30	43/300	5/300	714F/1
MHL8118★	40–1000	28	400	17.5/900	1	30	41.5/1000	8.5/1000	448/1
MHL8115★	40–1000	15	700	17.5/900	1	30	41.5/1000	8.5/1000	448/2
MHL8018★	40–1000	28	210	18.5/900	1	26	38.5/1000	7.5/1000	448/1
MHL8015★	40–1000	15	380	18.5/900	1	26	38.5/1000	7.5/1000	448/2

(46) To be introduced: a) 1Q97; b) 2Q97; c) 3Q97; d) 3Q97; e) 4Q97

★New Product



## Amplifier Modules (continued)

### TV Transmitters

**Table 4. UHF Ultra Linear for TV Applications**

These amplifiers are characterized for ultra-linear applications in Band IV and Band V TV transmitters.

Device	Frequency MHz	Pref Watts	Gp (Min)/Freq. Power Gain dB/MHz	3 Tone <sup>(8)</sup> IMD 1 dB	3 Tone <sup>(25)</sup> IMD 2 dB	VCC Volts	Class	Package/Style
MRFA2600 <sup>(26)</sup>	470–860	20	10.5/860	–50	–53	26.5	A	429A/1
MRFA2602 <sup>(28)</sup>	470–860	40	9/860	–50	–53	25.5	A	429C/1
RFA8090B	470–860	95 <sup>(11)</sup>	8/860	—	—	28	AB	429E/1
MRFA2604	470–860	180 <sup>(11)</sup>	8/860	—	—	28	AB	439/1

<sup>(8)</sup>Vision Carrier: – 8 dB; Sound Carrier: – 7 dB; Sideband Carrier: – 16 dB

<sup>(11)</sup>Output power at 1 dB compression in Class AB

<sup>(25)</sup>Vision Carrier: – 8 dB; Sound Carrier: – 10 dB; Sideband Carrier: – 16 dB

<sup>(26)</sup>Formerly known as "RFA6031"

<sup>(28)</sup>Formerly known as "RFA6060"

# CATV Distribution Amplifiers

Motorola Hybrids are manufactured using the latest generation technology which has set new standards for CATV system performance and reliability. These hybrids have been optimized to provide premium performance in all CATV systems up to 152 channels.

## Fiber Optic Receivers for HFC

### 40–860 MHz Hybrids

Device	Hybrid Responsivity Min dB	Flatness dB	Maximum Distortion Specifications		Equivalent Input Noise $\mu\text{A}/\sqrt{\text{Hz}}$ Max	Package/ Style
			IMD 2(52) dB	IMD 3(52) dB		
MHLW8000 ★	23.0	1.0	-70	-80	7.5	714U/1

Note: Please call your local Motorola Sales Office for information on optical connector options for this part.

## Forward Amplifiers

### 40/1000 MHz Hybrids, $V_{CC} = 24 \text{ Vdc}$ , Class A

Device	Hybrid Gain (Nom.) dB	Channel Loading Capacity	Maximum Distortion Specifications				Noise Figure @ 860 MHz dB Max	Package/ Style
			Output Level	2nd Order Test	Composite Triple Beat	Cross Modulation		
			dBmV	dB	dB	dB		
MHW9142	14	152	+38	-59(40)	-59	-63	8.5	714/1
MHW9182	18	152	+38	-59(40)	-59	-59	8.0	714/1
MHW9242 ★	24	152	+38	-59(40)	-58	-59	8	714/1

### 40–860 MHz Hybrids

Device	Gain dB Typ	Frequency MHz	$V_{CC}$ Volts	2nd Order IMD @ $V_{out} = 50 \text{ dBmV/ch}$ Max	DIN45004B @ $f=860 \text{ MHz}$ $\text{dB}_{\mu\text{V}}$ Min	Noise Figure @ 860 MHz dB Max	Package/ Style
CA901	17	40 – 860	24	-60	120	8	714P/2
CA901A	17	40 – 860	24	-64	120	8	714P/2

(40)Composite 2nd Order;  $V_{out} = +38 \text{ dBmV/ch}$

(52)Two laser test with 0.5 mW optical power at 40% modulation index per laser;  $f_1 = 373.25 \text{ MHz}$   $f_2 = 415.25 \text{ MHz}$

★New Product

## CATV Distribution: Forward Amplifiers (continued)

### 40–860 MHz Hybrids (continued)

Device	Gain dB Typ	Frequency MHz	V <sub>CC</sub> Volts	2nd Order IMD @ V <sub>out</sub> = 50 dBmV/ch Max	DIN45004B @ f=860 MHz dB <sub>μV</sub> Min	Noise Figure @ 860 MHz dB Max	Package/ Style
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#### Power Doubling Hybrids

CA922	17	40–860	24	–63	123	9.5	714P/2
CA922A	17	40–860	24	–67	123	9.5	714P/2

#### Hybrid Jumper

CATHRU	0	1–1000	75 Ohm Broadband Hybrid Jumper				714V
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### 40–860 MHz Hybrids, V<sub>CC</sub> = 24 Vdc, Class A

Device	Hybrid Gain (Nom.) dB	Channel Loading Capacity	Maximum Distortion Specifications				Noise Figure @ 860 MHz dB Max	Package/ Style
			Output Level dBmV	2nd Order Test dB	Composite Triple Beat	Cross Modulation FM = 55.25 MHz dB		
					128 CH	128 CH		
MHW8142	14	128	+38	–60(40)	–61	–66	8.0	714/1
MHW8182	18	128	+38	–60(40)	–60	–60	7	714/1
MHW8222	22	128	+38	–60(40)	–60	–60	7.5	714/1
MHW8242 *	24	128	+38	–60(40)	–60	–60	7.5	714/1
MHW8272 *	27	128	+38	–60(40)	–60	–60	7.0	714/1
MHW8292 *	29	128	+38	–56(40)	–60	–60	7.0	714/1

#### Power Doubling Hybrids

MHW8185 (46a)	18.5	128	+40	–62(39)	–64	–64	8.0	714Y/1
MHW8205 (46a)	20	128	+40	–60(39)	–63	–64	8.0	714Y/1

#### Feedforward Hybrids

MFF524B *	24	128	+44	–68(36)	–66	—	13.0	825A/2
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### 40–750 MHz Hybrids, V<sub>CC</sub> = 24 Vdc, Class A

Device	Hybrid Gain (Nom.) dB	Channel Loading Capacity	Maximum Distortion Specifications				Noise Figure @ 750 MHz dB Max	Package/ Style
			Output Level dBmV	2nd Order Test dB	Composite Triple Beat	Cross Modulation FM = 55.25 MHz dB		
					110 CH	110 CH		
MHW7142	14	110	+40	–60(39)	–62	–66	8.0	714/1
MHW7182	18	110	+40	–62(39)	–62	–64	6.5	714/1
MHW7222	22	110	+40	–55(39)	–60	–60	7	714/1
MHW7242 *	24	110	+40	–60(39)	–60	–60	7	714/1
MHW7272 *	27	110	+40	–60(39)	–60	–60	6.5	714/1
MHW7292 *	29	110	+40	–60(39)	–60	–60	6.5	714/1

(36) Composite 2nd order; V<sub>out</sub> = +44 dBmV/ch

(39) Composite 2nd order; V<sub>out</sub> = +40 dBmV/ch

(40) Composite 2nd Order; V<sub>out</sub> = +38 dBmV/ch

(46) To be introduced: a) 1Q97; b) 2Q97; c) 3Q97; d) 3Q97; e) 4Q97

\*New Product

## CATV Distribution: Forward Amplifiers (continued)

### 40–750 MHz Hybrids, $V_{CC} = 24$ Vdc, Class A (continued)

Device	Hybrid Gain (Nom.) dB	Channel Loading Capacity	Maximum Distortion Specifications				Noise Figure @ 750 MHz dB Max	Package/Style
			Output Level	2nd Order Test	Composite Triple Beat	Cross Modulation FM = 55.25 MHz dB		
			dBmV	dB	dB	dB		
					110 CH	110 CH		

#### Power Doubling Hybrids

MHW7185A	18.5	110	+44	-58 <sup>(36)</sup>	-58	-65	8.5	714/1
MHW7185B (46a)	18.5	110	+44	-58	-58	-65	8.5	714Y/1
MHW7185C (46a)	18.8	110	+44	-62	-62	-62	8.0	714Y/1
MHW7205A	20	110	+44	-56 <sup>(36)</sup>	-57	-64	8.0	714/1
MHW7205B (46a)	20	110	+44	-58	-57	-64	8.0	714Y/1
MHW7205C (46a)	20	110	+44	-61	-61	-61	8.0	714Y/1

#### Feedforward Hybrids

MFF424B	24	110	+44	-70 <sup>(36)</sup>	-68	—	13	825A/2
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### 40–600 MHz Hybrids, $V_{CC} = 24$ Vdc, Class A

Device	Hybrid Gain (Nom.) dB	Channel Loading Capacity	Maximum Distortion Specifications				Noise Figure @ 600 MHz dB Max	Package/Style
			Output Level	2nd Order Test	Composite Triple Beat	Cross Modulation		
			dBmV	dB	dB	dB		
					87 CH	87 CH		

MHW6182-6	18	87	+44	-56 <sup>(36)</sup>	-57	-55	6	714/1
MHW6222-6	22	87	+44	-56 <sup>(36)</sup>	-56	-56	6	714/1
MHW6272-6 (46a)	27	87	+44	-63 <sup>(36)</sup>	-57	-55	6.5	714/1
MHW6292-6 (46a)	29	87	+44	-63 <sup>(36)</sup>	-57	-55	6.5	714/1

#### Power Doubling Hybrids

MHW6185-6A *	18	87	+44	-64 <sup>(36)</sup>	-64	-66	7	714/1
MHW6205-6A *	20	87	+44	-63 <sup>(36)</sup>	-63	-65	6.5	714/1

#### Feedforward Hybrids

MFF324B	24	85	+44	-86 <sup>(38)</sup>	-73	-68	12.5	825A/2
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<sup>(36)</sup>Composite 2nd order;  $V_{out} = +44$  dBmV/ch

<sup>(38)</sup>Channels 2 and M39 @ M48

<sup>(46)</sup>To be introduced: a) 1Q97; b) 2Q97; c) 3Q97; d) 3Q97; e) 4Q97

\*New Product

## CATV Distribution: Forward Amplifiers (continued)

### 40–550 MHz Hybrids, V<sub>CC</sub> = 24 Vdc, Class A

Device	Hybrid Gain (Nom.) dB	Channel Loading Capacity	Maximum Distortion Specifications				Noise Figure @ 550 MHz dB Max	Package/Style
			Output Level dBmV	2nd Order Test dB	Composite Triple Beat	Cross Modulation		
					dB	dB		
MHW6142	14	77	+44	-72 <sup>(35)</sup>	-59	-62	7.5	714/1
MHW6172	17	77	+44	-72 <sup>(35)</sup>	-59	-62	7	714/1
MHW6182	18	77	+44	-72 <sup>(35)</sup>	-58	-62	7	714/1
MHW6222	22	77	+44	-66 <sup>(35)</sup>	-57	-57	6	714/1
MHW6272	27	77	+44	-64 <sup>(35)</sup>	-57	-57	6.5	714/1
MHW6342	34	77	+44	-64 <sup>(35)</sup>	-57	-57	6.5	714/1

### Power Doubling Hybrids

MHW6185B	18	77	+44	-65 <sup>(36)</sup>	-65	-68	7.5	714/1
MHW6205	20	77	+44	-60 <sup>(36)</sup>	-64	-67	7.5	714/1
MHW6225	22	77	+44	-55 <sup>(36)</sup>	-62	-60	7.0	714/1

### Feedforward Hybrids

MFF224B	24	77	+44	-86 <sup>(35)</sup>	-75	-70	11	825A/2
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### 40–450 MHz Hybrids, V<sub>CC</sub> = 24 Vdc, Class A

Device	Hybrid Gain (Nom.) dB	Channel Loading Capacity	Maximum Distortion Specifications				Noise Figure @ 450 MHz dB Max	Package/Style
			Output Level dBmV	2nd Order Test dB	Composite Triple Beat	Cross Modulation		
					dB	dB		
MHW5142A	14	60	+46	-74 <sup>(31)</sup>	-61	-62	7	714/1
MHW5172A	17	60	+46	-74 <sup>(31)</sup>	-60	-62	7	714/1
MHW5182A	18	60	+46	-72 <sup>(31)</sup>	-61	-59	6.5	714/1
MHW5222A	22	60	+46	-72 <sup>(31)</sup>	-60	-59	5.5	714/1
MHW5272A	27	60	+46	-68 <sup>(31)</sup>	-59	-60	6.0	714/1
MHW5342A	34	60	+46	-68 <sup>(31)</sup>	-59	-59	6.0	714/1
MHW5382A	38	60	+46	-64 <sup>(31)</sup>	-59	-59	5.0	714/1

### Power Doubling Hybrids

MHW5185B	18	60	+46	-67 <sup>(32)</sup>	-67	-67	7.0	714/1
MHW5225	22	60	+46	-69 <sup>(31)</sup>	-62	-62	6.0	714/1

### Feedforward Hybrids

MFF124B	24	60	+46	-84 <sup>(31)</sup>	-79	-75	10	825A/2
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<sup>(31)</sup>Channels 2 and M13 @ M22

<sup>(32)</sup>Composite 2nd order; V<sub>out</sub> = +46 dBmV/ch

<sup>(35)</sup>Channels 2 and M30 @ M39

<sup>(36)</sup>Composite 2nd order; V<sub>out</sub> = +44 dBmV/ch

# Reverse Amplifiers

5–200 MHz Hybrids, V<sub>CC</sub> = 24 Vdc, Class A

Device	Hybrid Gain (Nom.) dB	Channel Loading Capacity	Maximum Distortion Specifications						Noise Figure @ 175 MHz dB Max	Package/Style
			Output Level dBmV	2nd Order Test <sup>(30)</sup> dB	Composite Triple Beat		Cross Modulation			
					dB		dB			
					22 CH	26 CH	22 CH	26 CH		
MHW1134	13	22	+50	-72	-73	-71(19)	-65	-65(19)	7	714/1
MHW1184	18	22	+50	-72	-70	-70(19)	-64	-64(19)	5.5	714/1
MHW1224	22	22	+50	-72	-69	-68.5(19)	-62	-62(19)	5.5	714/1
MHW1244	24	22	+50	-72	-68	-67.5(19)	-61	-61(19)	5	714/1

Low Current Amplifiers — 5–50 MHz Hybrids, V<sub>CC</sub> = 24 Vdc, Class A

Device	Hybrid Gain (Nom.) dB	Channel Loading Capacity	I <sub>DC</sub> mA Max	Maximum Distortion Specifications				Noise Figure @ 50 MHz dB Max	Package/Style		
				Output Level dBmV	2nd Order Test <sup>(30)</sup> dB	Composite Triple Beat	Cross Modulation				
						dB				dB	
						4 CH	4 CH				
MHW1184L	18	4	135	+50	-70	-73	-64	5	714/1		
MHW1224L	22	4	135	+50	-70	-72	-63	5	714/1		
MHW1254L	25	4	135	+50	-70	-70	-62	4.5	714/1		
MHW1304L	30	4	135	+50	-70	-66	-57	4.5	714/1		

<sup>(19)</sup>Typical

<sup>(30)</sup>Channels 2 and A @ 7

# Surface Mount Information

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## In Brief . . .

Surface Mount Technology is now being utilized to offer answers to many problems that have been created in the use of insertion technology.

Limitations have been reached with insertion packages and PC board technology. Surface Mount Technology offers the opportunity to continue to advance the state-of-the-art designs that cannot be accomplished with Insertion Technology.

Surface Mount Packages allow more optimum device performance with the smaller Surface Mount configuration. Internal lead lengths, parasitic capacitance and inductance that placed limitations on chip performance have been reduced.

The lower profile of Surface Mount Packages allows more boards to be utilized in a given amount of space. They are stacked closer together and utilize less total volume than insertion populated PC boards.

Printed circuit costs are lowered with the reduction of the number of board layers required. The elimination or reduction of the number of plated through holes in the board contribute significantly to lower PC board prices.

Surface Mount assembly does not require the preparation of components that is common on insertion technology lines. Surface Mount components are sent directly to the assembly line, eliminating an intermediate step.

Automatic placement equipment is available that can place Surface Mount components at the rate of a few thousand per hour to hundreds of thousands of components per hour.

Surface Mount Technology is cost effective, allowing the manufacturer the opportunity to produce smaller units and offer increased functions with the same size product.

	<b>Page</b>
Information for Using Surface Mount Packages . . . .	5.11-2
Footprints for Soldering . . . . .	5.11-5

# INFORMATION FOR USING SURFACE MOUNT PACKAGES

## RECOMMENDED FOOTPRINTS FOR SURFACE MOUNTED APPLICATIONS

Surface mount board layout is a critical portion of the total design. The footprint for the semiconductor packages must be the correct size to ensure proper solder connection interface between the board and the package. With the correct pad

geometry, the packages will self align when subjected to a solder reflow process.

### POWER DISSIPATION FOR A SURFACE MOUNT DEVICE

The power dissipation for a surface mount device is a function of the drain/collector pad size. These can vary from the minimum pad size for soldering to a pad size given for maximum power dissipation. Power dissipation for a surface mount device is determined by  $T_{J(max)}$ , the maximum rated junction temperature of the die,  $R_{\theta JA}$ , the thermal resistance from the device junction to ambient, and the operating temperature,  $T_A$ . Using the values provided on the data sheet,  $P_D$  can be calculated as follows:

$$P_D = \frac{T_{J(max)} - T_A}{R_{\theta JA}}$$

The values for the equation are found in the maximum ratings table on the data sheet. Substituting these values into the equation for an ambient temperature  $T_A$  of 25°C, one can calculate the power dissipation of the device. For example, for a SOT-223 device,  $P_D$  is calculated as follows.

$$P_D = \frac{150^\circ\text{C} - 25^\circ\text{C}}{156^\circ\text{C/W}} = 800 \text{ milliwatts}$$

The 156°C/W for the SOT-223 package assumes the use of the recommended footprint on a glass epoxy printed circuit board to achieve a power dissipation of 800 milliwatts. There are other alternatives to achieving higher power dissipation from the surface mount packages. One is to increase the area of the drain/collector pad. By increasing the area of the drain/collector pad, the power dissipation can be increased. Although the power dissipation can almost be doubled with this method, area is taken up on the printed circuit board which can defeat the purpose of using surface mount technology. For example, a graph of  $R_{\theta JA}$  versus drain pad area is shown in Figures 1, 2 and 3.

Another alternative would be to use a ceramic substrate or an aluminum core board such as Thermal Clad™. Using a board material such as Thermal Clad, an aluminum core board, the power dissipation can be doubled using the same footprint.

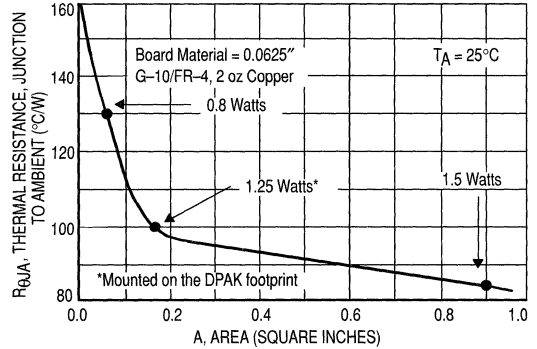


Figure 1. Thermal Resistance versus Drain Pad Area for the SOT-223 Package (Typical)

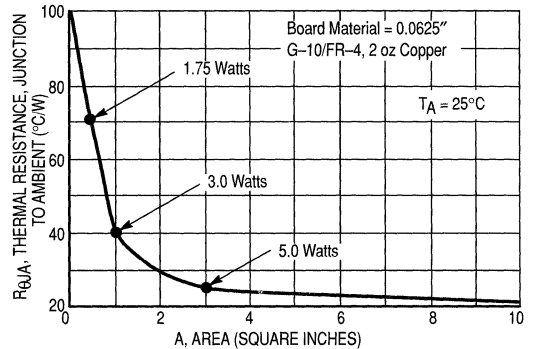


Figure 2. Thermal Resistance versus Drain Pad Area for the DPAK Package (Typical)

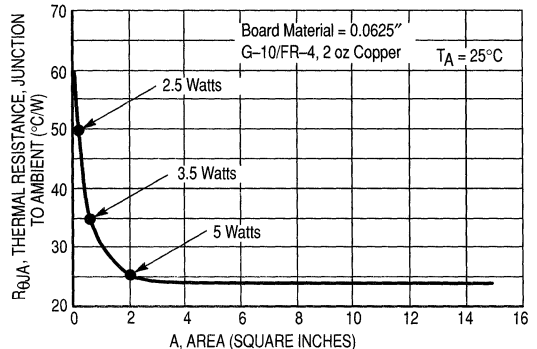


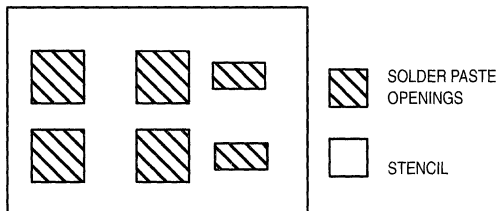
Figure 3. Thermal Resistance versus Drain Pad Area for the D²PAK Package (Typical)



## SOLDER STENCIL GUIDELINES

Prior to placing surface mount components onto a printed circuit board, solder paste must be applied to the pads. Solder stencils are used to screen the optimum amount. These stencils are typically 0.008 inches thick and may be made of brass or stainless steel. For packages such as the TSOP-6, SC-59, SC-70/SOT-323, SOD-123, SOT-23, SOT-143, SOT-223, SO-8, SO-14, SO-16, Micro8, and SMA/SMB/SMC diode packages, the stencil opening should be the same as the pad size or a 1:1 registration. This is not the case with the DPAK, D<sup>2</sup>PAK and D<sup>3</sup>PAK packages. If a 1:1 opening is used to screen solder onto the drain pad, misalignment and/or "tombstoning" may occur due to an excess of solder. For these two packages, the opening in the stencil for the paste should be approximately 50% of the tab area. The opening for the leads is still a 1:1 registration. Figure 4 shows a typical stencil for the DPAK, D<sup>2</sup>PAK and D<sup>3</sup>PAK packages. The pattern of the opening in the stencil

for the drain pad is not critical as long as it allows approximately 50% of the pad to be covered with paste.



**Figure 4. Typical Stencil for DPAK, D<sup>2</sup>PAK and D<sup>3</sup>PAK Packages**

## SOLDERING PRECAUTIONS

The melting temperature of solder is higher than the rated temperature of the device. When the entire device is heated to a high temperature, failure to complete soldering within a short time could result in device failure. Therefore, the following items should always be observed in order to minimize the thermal stress to which the devices are subjected.

- Always preheat the device.
- The delta temperature between the preheat and soldering should be 100°C or less.\*
- When preheating and soldering, the temperature of the leads and the case must not exceed the maximum temperature ratings as shown on the data sheet. When using infrared heating with the reflow soldering method, the difference should be a maximum of 10°C.
- The soldering temperature and time should not exceed 260°C for more than 10 seconds.
- When shifting from preheating to soldering, the maximum temperature gradient shall be 5°C or less.

- After soldering has been completed, the device should be allowed to cool naturally for at least three minutes. Gradual cooling should be used since the use of forced cooling will increase the temperature gradient and will result in latent failure due to mechanical stress.
- Mechanical stress or shock should not be applied during cooling.

\* Soldering a device without preheating can cause excessive thermal shock and stress which can result in damage to the device.

\* Due to shadowing and the inability to set the wave height to incorporate other surface mount components, the D<sup>2</sup>PAK is not recommended for wave soldering.

## TYPICAL SOLDER HEATING PROFILE

For any given circuit board, there will be a group of control settings that will give the desired heat pattern. The operator must set temperatures for several heating zones and a figure for belt speed. Taken together, these control settings make up a heating "profile" for that particular circuit board. On machines controlled by a computer, the computer remembers these profiles from one operating session to the next. Figure 5 shows a typical heating profile for use when soldering a surface mount device to a printed circuit board. This profile will vary among soldering systems, but it is a good starting point. Factors that can affect the profile include the type of soldering system in use, density and types of components on the board, type of solder used, and the type of board or substrate material being used. This profile shows temperature versus time. The

line on the graph shows the actual temperature that might be experienced on the surface of a test board at or near a central solder joint. The two profiles are based on a high density and a low density board. The Vitronics SMD310 convection/infrared reflow soldering system was used to generate this profile. The type of solder used was 62/36/2 Tin Lead Silver with a melting point between 177–189°C. When this type of furnace is used for solder reflow work, the circuit boards and solder joints tend to heat first. The components on the board are then heated by conduction. The circuit board, because it has a large surface area, absorbs the thermal energy more efficiently, then distributes this energy to the components. Because of this effect, the main body of a component may be up to 30 degrees cooler than the adjacent solder joints.

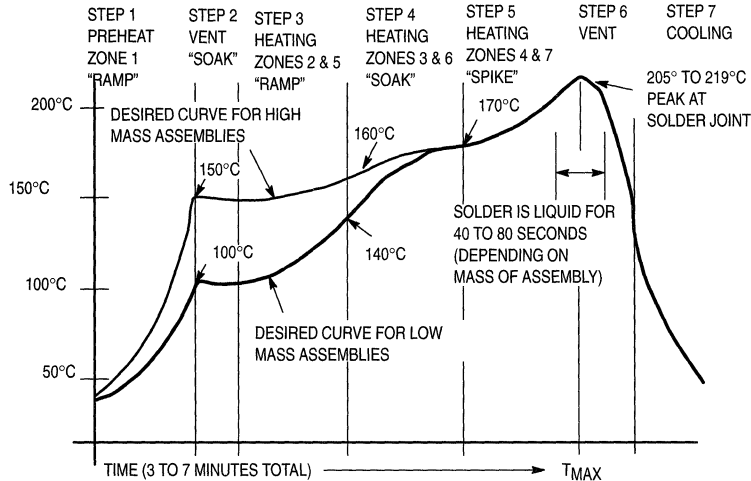
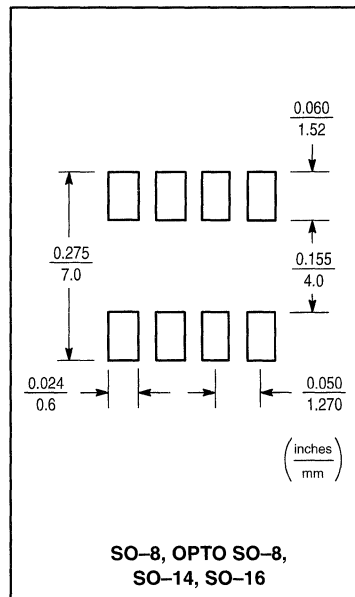
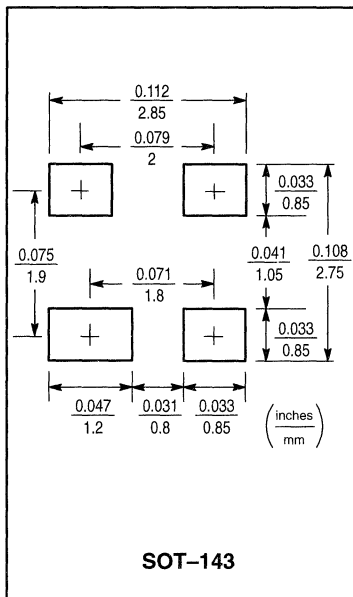
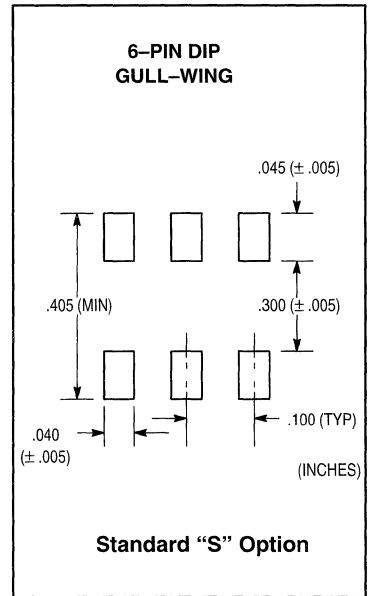
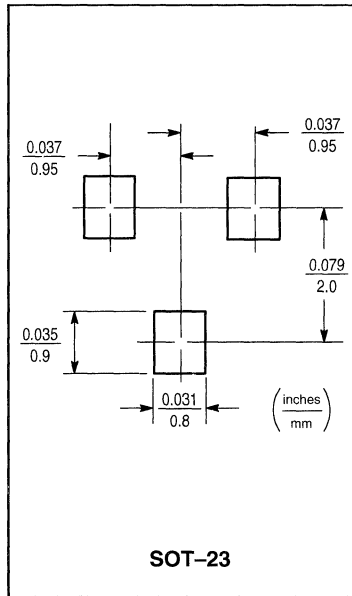
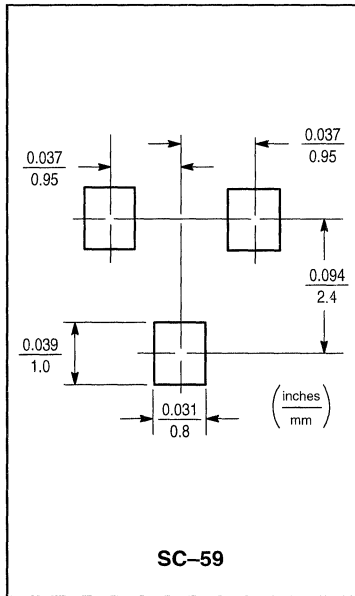
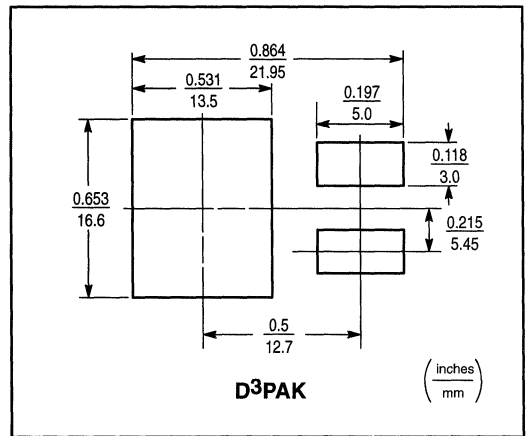
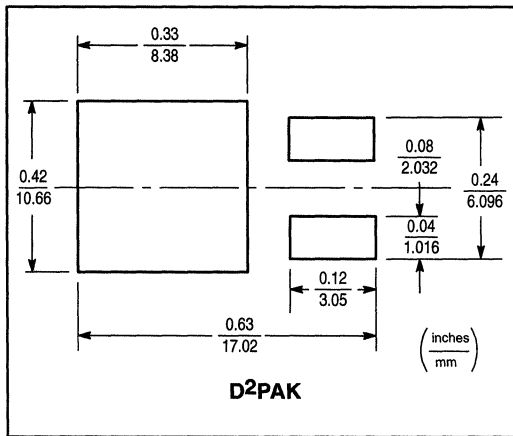
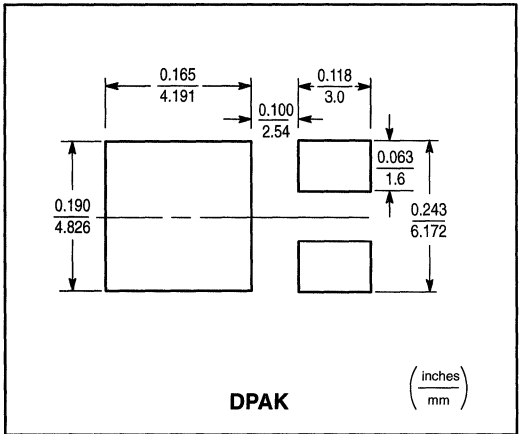
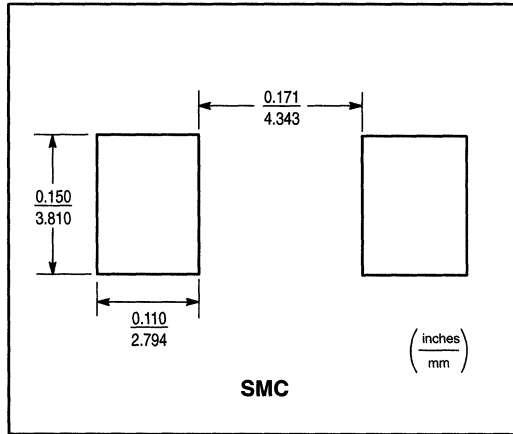
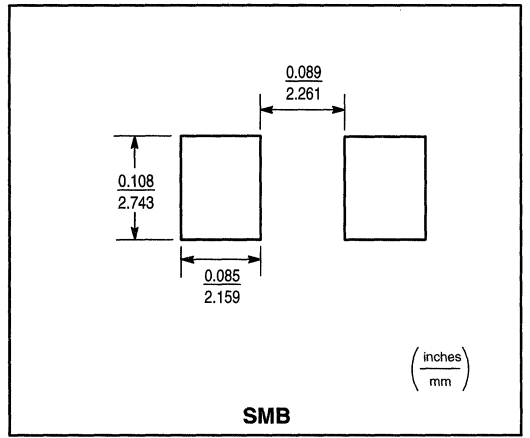
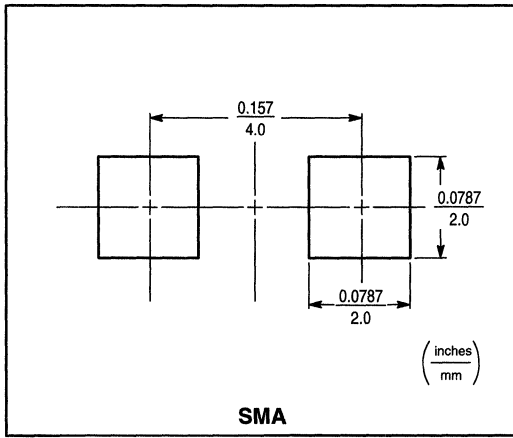
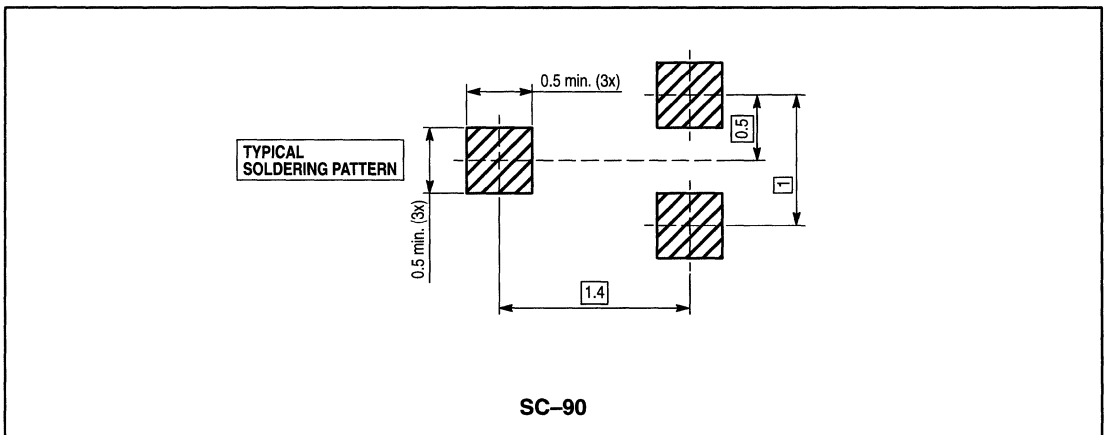
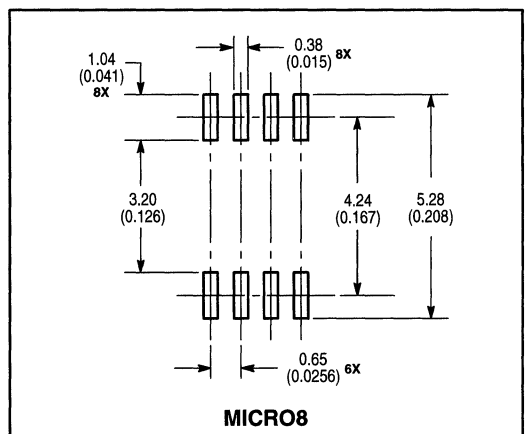
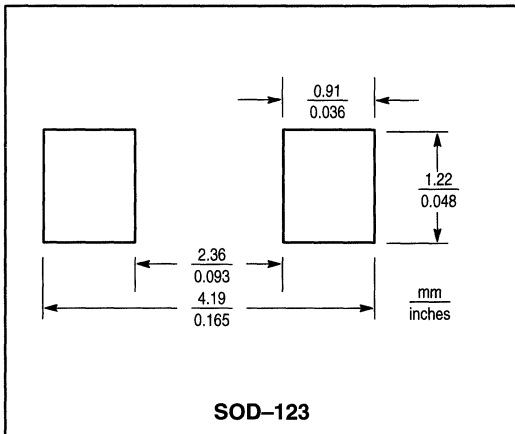
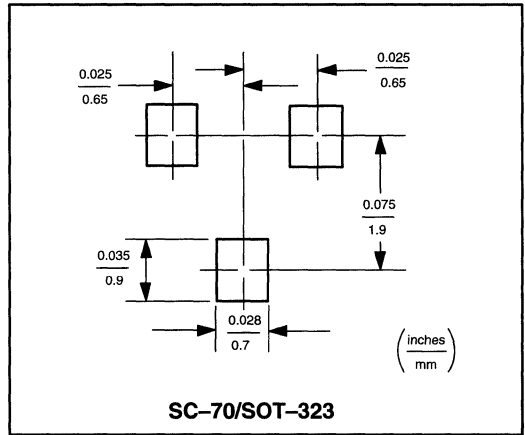
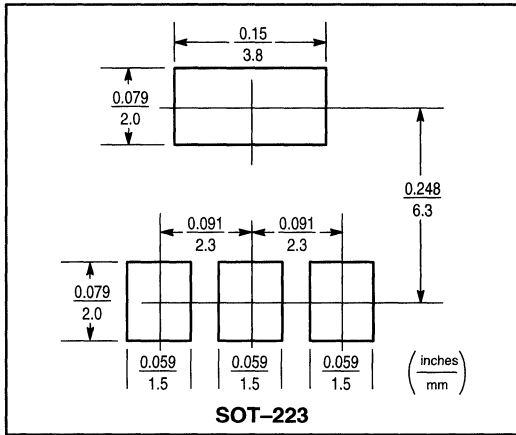


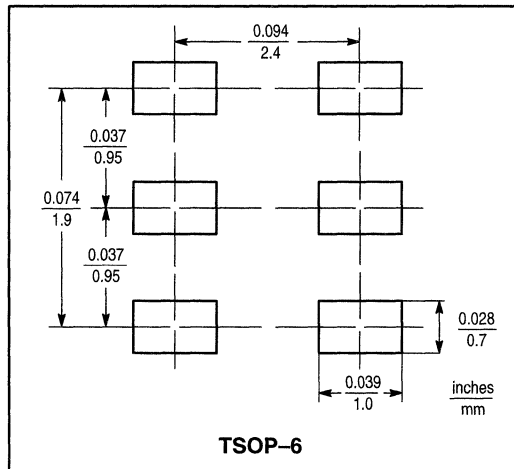
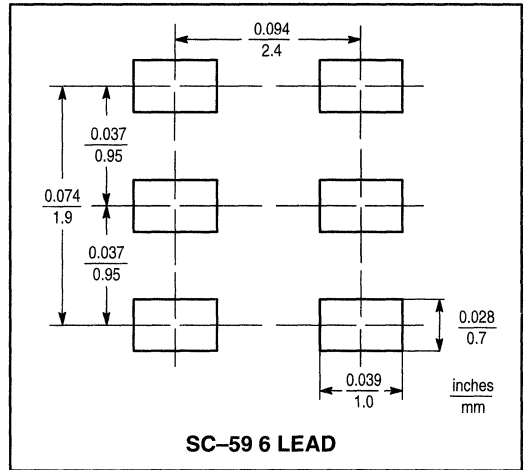
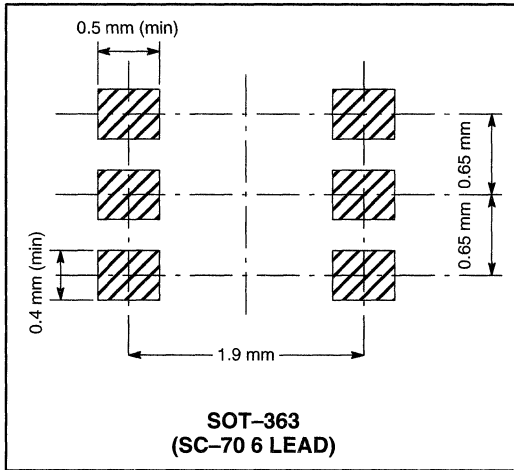
Figure 5. Typical Solder Heating Profile

# Footprints for Soldering









# Tape and Reel Specifications and Packaging Specifications

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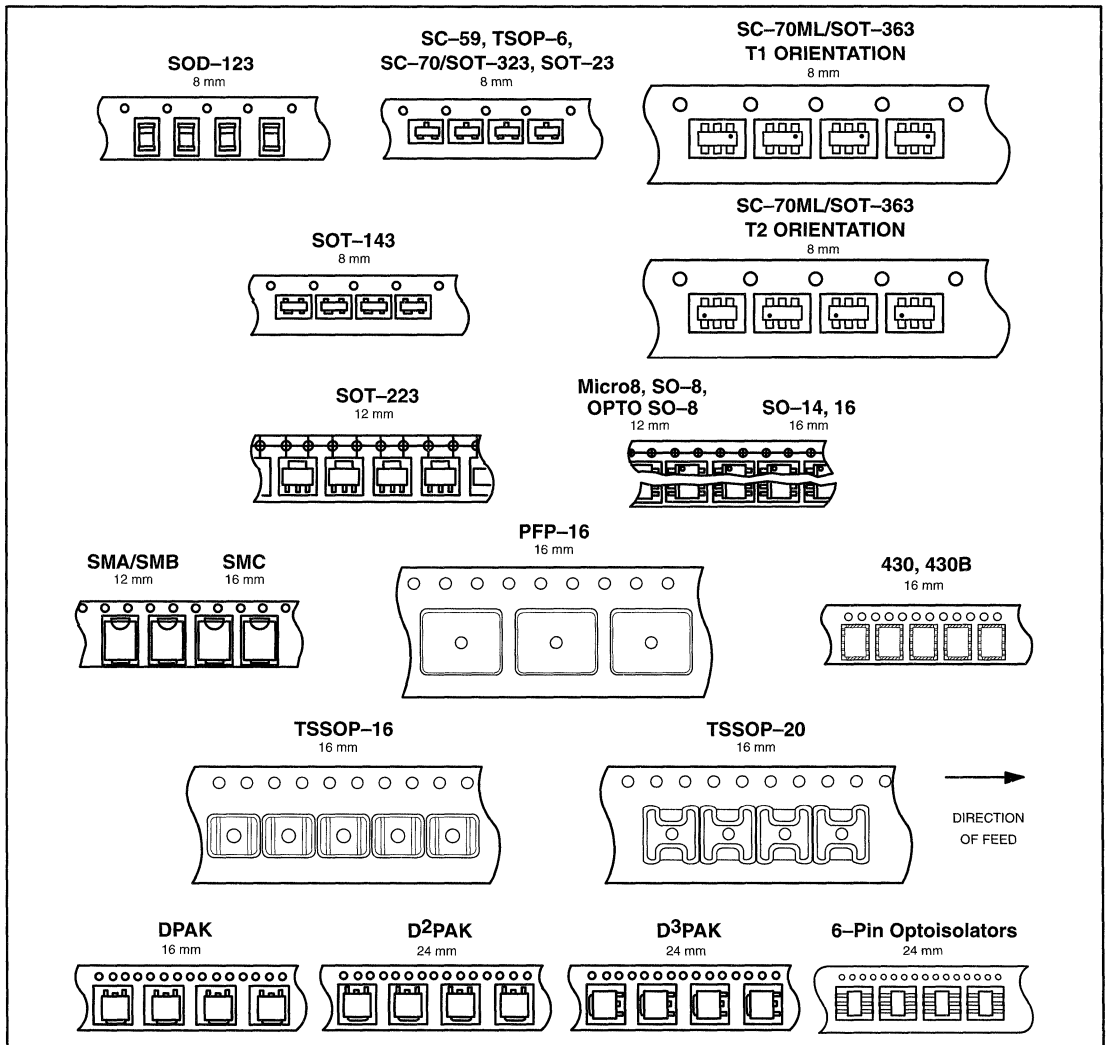
	<b>Page</b>
Tape and Reel Specifications .....	5.12-2
Embossed Tape and Reel Ordering Information .	5.12-3
Embossed Tape and Reel Data for Discretes ...	5.12-4
Lead Tape Packaging Standards for Axial-Lead Components .....	5.12-6
Packaging Specifications .....	5.12-7
TO-92 EIA Radial Tape in Fan Fold Box or on Reel .....	5.12-7
Fan Fold Box Styles .....	5.12-9
Adhesion Pull Tests .....	5.12-9
Reel Styles .....	5.12-10
DO-35, DO-41, Surmetic 30 Radial Tape in Fan Fold Box or On Reel .....	5.12-11

# Tape and Reel Specifications and Packaging Specifications

Embossed Tape and Reel is used to facilitate automatic pick and place equipment feed requirements. The tape is used as the shipping container for various products and requires a minimum of handling. The antistatic/conductive tape provides a secure cavity for the product when sealed with the "peel-back" cover tape.

- Two Reel Sizes Available (7" and 13")
- Used for Automatic Pick and Place Feed Systems
- Minimizes Product Handling
- EIA 481, -1, -2
- SOD-123, SC-59, SC-70/SOT-323, SC-70ML/SOT-363, SOT-23, SOT-143, TSOP-6, in 8 mm Tape
- SO-8, Micro8, OPTO SO-8, SOT-223, SMA, SMB in 12 mm Tape
- DPAK, PFP-16, SO-14, SO-16, SMC, TSSOP-16, TSSOP-20, 430 and 430B in 16 mm Tape
- D<sup>2</sup>PAK, D<sup>3</sup>PAK, 6-Pin Optoisolators in 24 mm Tape

Use the standard device title and add the required suffix as listed in the option table on the following page. Note that the individual reels have a finite number of devices depending on the type of product contained in the tape. Also note the minimum lot size is one full reel for each line item, and orders are required to be in increments of the single reel quantity.



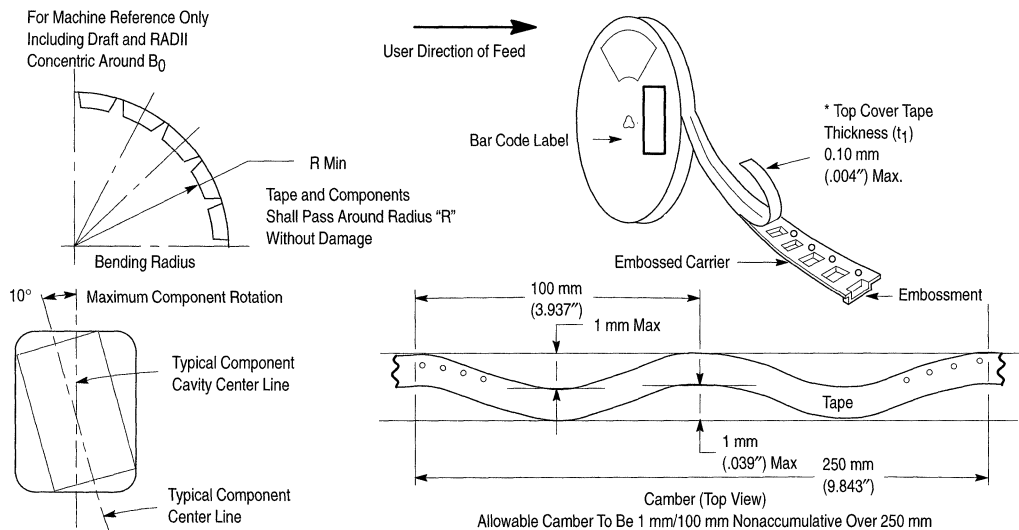
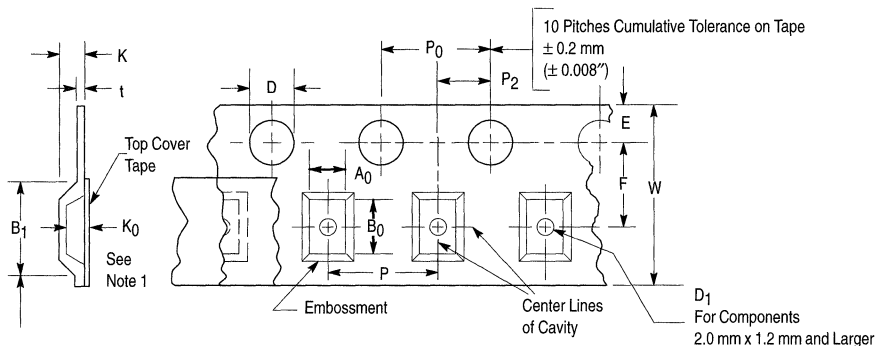


## EMBOSSED TAPE AND REEL ORDERING INFORMATION

Package	Tape Width (mm)	Pitch mm (inch)	Reel Size mm (inch)	Devices Per Reel and Minimum Order Quantity	Device Suffix
DPAK	16	8.0 ± 0.1 (.315 ± .004)	330 (13)	2,500	T4
D <sup>2</sup> PAK	24	16.0 ± 0.1 (.630 ± .004)	330 (13)	800	T4
D <sup>3</sup> PAK	24	24.0 ± 0.1 (.945 ± .004)	330 (13)	500	RL
SC-59/TSOP-6	8	4.0 ± 0.1 (.157 ± .004)	178 (7)	3,000	T1
SC-70/SOT-323	8	4.0 ± 0.1 (.157 ± .004)	178 (7)	3,000	T1
	8		330 (13)	10,000	T3
SC-70ML/SOT-363	8	4.0 ± 0.1 (.157 ± .004)	178 (7)	3,000	T1
	8		178 (7)	3,000	T2
SMA	12	8.0 ± 0.1 (.315 ± .004)	330 (13)	5,000	T3
SMB	12	8.0 ± 0.1 (.315 ± .004)	330 (13)	2,500	T3
SMC	16	8.0 ± 0.1 (.315 ± .004)	330 (13)	2,500	T3
SO-8, OPTO SO-8	12	8.0 ± 0.1 (.315 ± .004)	178 (7)	500	R1
	12		330 (13)	2,500	R2
SO-14	16	8.0 ± 0.1 (.315 ± .004)	178 (7)	500	R1
	16		330 (13)	2,500	R2
SO-16	16	8.0 ± 0.1 (.315 ± .004)	178 (7)	500	R1
	16		330 (13)	2,500	R2
SOD-123	8	4.0 ± 0.1 (.157 ± .004)	178 (7)	3,000	T1
	8		330 (13)	10,000	T3
SOT-23	8	4.0 ± 0.1 (.157 ± .004)	178 (7)	3,000	T1
	8		330 (13)	10,000	T3
SOT-143	8	4.0 ± 0.1 (.157 ± .004)	178 (7)	3,000	T1
	8		330 (13)	10,000	T3
SOT-223	12	8.0 ± 0.1 (.315 ± .004)	178 (7)	1,000	T1
	12		330 (13)	4,000	T3
6-Pin Optoisolators	24	12.0 ± 0.1 (.472 ± .004)	330 (13)	1000	R2
Micro8	12	8.0 ± 0.1 (.315 ± .003)	330 (13)	4000	R2
PFP-16	16	12.0 ± 0.1 (.471 ± .004)	330 (13)	1,500	R2
TSSOP-16	16	8.0 ± 0.1 (.315 ± .004)	330 (13)	2,500	R2
TSSOP-20	16	8.0 ± 0.1 (.315 ± .004)	330 (13)	2,500	R2
430, 430B	16	8.0 ± 0.1 (.315 ± .004)	178 (7)	500	R1

# EMBOSSED TAPE AND REEL DATA FOR DISCRETES

## CARRIER TAPE SPECIFICATIONS



### DIMENSIONS

Tape Size	B <sub>1</sub> Max	D	D <sub>1</sub>	E	F	K	P <sub>0</sub>	P <sub>2</sub>	R Min	T Max	W Max
8 mm	4.55 mm (.179")	1.5±0.1 mm -0.0	1.0 Min (.039")	1.75±0.1 mm (.069±.004")	3.5±0.05 mm (.138±.002")	2.4 mm Max (.094")	4.0±0.1 mm (.157±.004")	2.0±0.1 mm (.079±.002")	25 mm (.98")	0.6 mm (.024")	8.3 mm (.327")
12 mm	8.2 mm (.323")	1.5±0.1 mm -0.0	1.5 mm Min (.060")		5.5±0.05 mm (.217±.002")	6.4 mm Max (.252")					12±.30 mm (.470±.012")
16 mm	12.1 mm (.476")		7.5±0.10 mm (.295±.004")		7.9 mm Max (.311")	16.3 mm (.642")					
24 mm	20.1 mm (.791")		11.5±0.1 mm (.453±.004")		11.9 mm Max (.468")	24.3 mm (.957")					

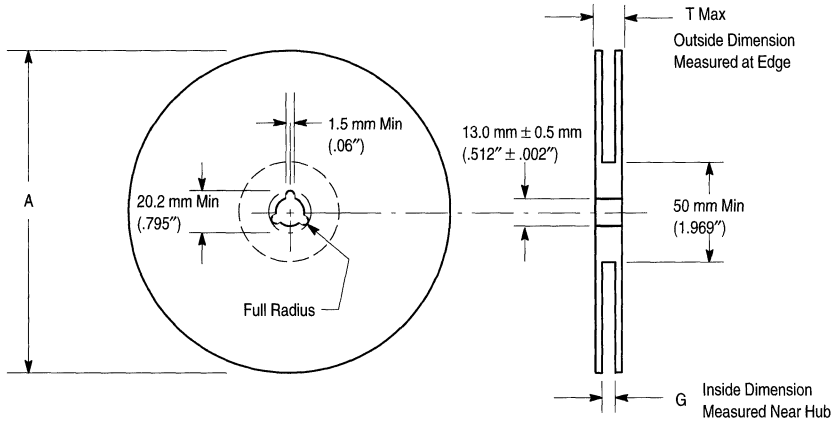
Metric dimensions govern — English are in parentheses for reference only.

NOTE 1: A<sub>0</sub>, B<sub>0</sub>, and K<sub>0</sub> are determined by component size. The clearance between the components and the cavity must be within .05 mm min. to .50 mm max., the component cannot rotate more than 10° within the determined cavity.

NOTE 2: If B<sub>1</sub> exceeds 4.2 mm (.165) for 8 mm embossed tape, the tape may not feed through all tape feeders.

NOTE 3: Pitch information is contained in the Embossed Tape and Reel Ordering Information on pg. 5.12-3.

## EMBOSSED TAPE AND REEL DATA FOR DISCRETES



Size	A Max	G	T Max
8 mm	330 mm (12.992")	8.4 mm + 1.5 mm, -0.0 (.33" + .059", -0.00)	14.4 mm (.56")
12 mm	330 mm (12.992")	12.4 mm + 2.0 mm, -0.0 (.49" + .079", -0.00)	18.4 mm (.72")
16 mm	360 mm (14.173")	16.4 mm + 2.0 mm, -0.0 (.646" + .078", -0.00)	22.4 mm (.882")
24 mm	360 mm (14.173")	24.4 mm + 2.0 mm, -0.0 (.961" + .070", -0.00)	30.4 mm (1.197")

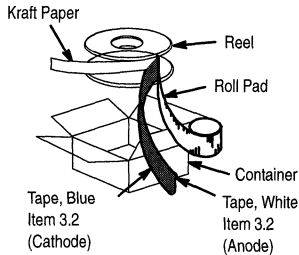
### Reel Dimensions

Metric Dimensions Govern — English are in parentheses for reference only

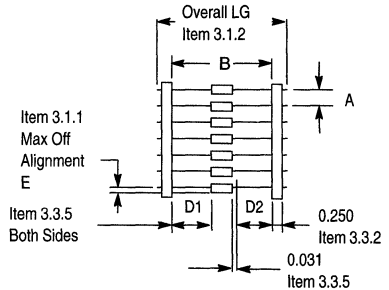
## LEAD TAPE PACKAGING STANDARDS FOR AXIAL-LEAD COMPONENTS

Case Type	Product Category	Device Title Suffix	MPQ Quantity Per Reel (Item 3.3.7)	Component Spacing A Dimension	Tape Spacing B Dimension	Reel Dimension C	Reel Dimension D (Max)	Max Off Alignment E
Case 17-02	Surmetic 40 & 600 Watt TVS	RL	4000	0.2 +/- 0.015	2.062 +/- 0.059	3	14	0.047
Case 41A-02	1500 Watt TVS	RL4	1500	0.4 +/- 0.02	2.062 +/- 0.059	3	14	0.047
Case 51-02	DO-7 Glass (For Reference only)	RL	3000	0.2 +/- 0.02	2.062 +/- 0.059	3	14	0.047
Case 59-03	DO-41 Glass & DO-41 Surmetic 30	RL	6000	0.2 +/- 0.015	2.062 +/- 0.059	3	14	0.047
	Rectifier							
Case 59-04	500 Watt TVS	RL	5000	0.2 +/- 0.02	2.062 +/- 0.059	3	14	0.047
	Rectifier							
Case 194-04	110 Amp TVS (Automotive)	RL	800	0.4 +/- 0.02	1.875 +/- 0.059	3	14	0.047
	Rectifier							
Case 267-02	Rectifier	RL	1500	0.4 +/- 0.02	2.062 +/- 0.059	3	14	0.047
Case 299-02	DO-35 Glass	RL	5000	0.2 +/- 0.02	2.062 +/- 0.059	3	14	0.047

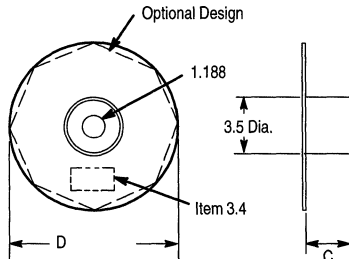
**Table 1. Packaging Details (all dimensions in inches)**



**Figure 1. Reel Packing**



**Figure 2. Component Spacing**



**Figure 3. Reel Dimensions**

# TO-92 EIA, IEC, EIAJ Radial Tape in Fan Fold Box or On Reel

Radial tape in fan fold box or on reel of the reliable TO-92 package are the best methods of capturing devices for automatic insertion in printed circuit boards. These methods of taping are compatible with various equipment for active and passive component insertion.

- Available in Fan Fold Box
- Available on 365 mm Reels
- Accommodates All Standard Inserters
- Allows Flexible Circuit Board Layout
- 2.5 mm Pin Spacing for Soldering
- EIA-468, IEC 286-2, EIAJ RC1008B

## Ordering Notes:

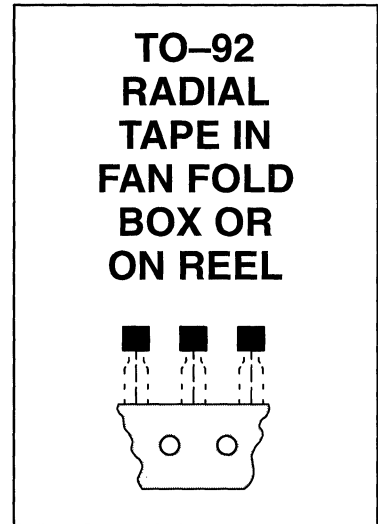
When ordering radial tape in fan fold box or on reel, specify the style per Figures 3 through 8. Add the suffix "RLR" and "Style" to the device title, i.e. MPS3904RLRA. This will be a standard MPS3904 radial taped and supplied on a reel per Figure 9.

Fan Fold Box Information — Minimum order quantity 1 Box/\$200LL.

Order in increments of 2000.

Reel Information — Minimum order quantity 1 Reel/\$200LL.

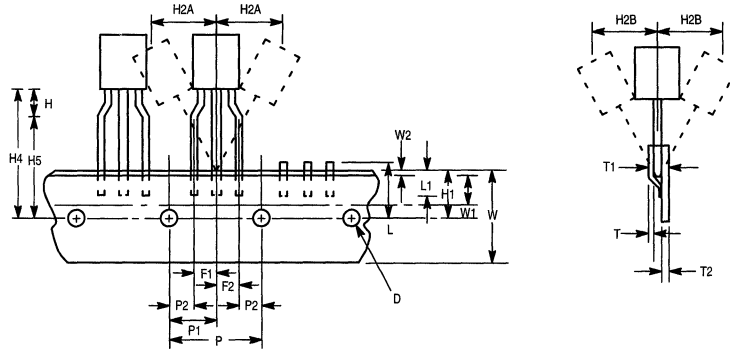
Order in increments of 2000.



## US/European Suffix Conversions

US	EUROPE
RLRA	RL
RLRE	RL1
RLRM	ZL1

## TO-92 EIA RADIAL TAPE IN FAN FOLD BOX OR ON REEL



**Figure 1. Device Positioning on Tape**

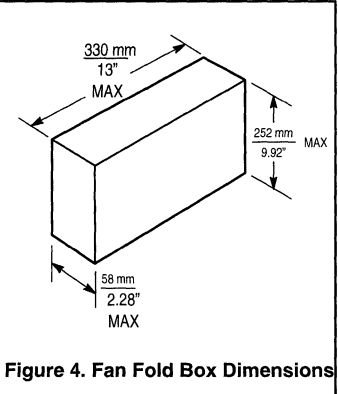
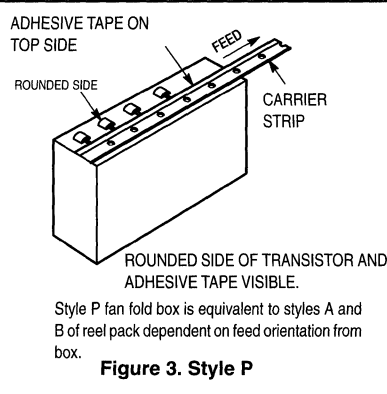
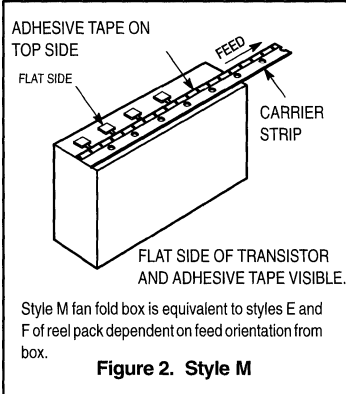
Symbol	Item	Specification			
		Inches		Millimeter	
		Min	Max	Min	Max
D	Tape Feedhole Diameter	0.1496	0.1653	3.8	4.2
D2	Component Lead Thickness Dimension	0.015	0.020	0.38	0.51
F1, F2	Component Lead Pitch	0.0945	0.110	2.4	2.8
H	Bottom of Component to Seating Plane	.059	.156	1.5	4.0
H1	Feedhole Location	0.3346	0.3741	8.5	9.5
H2A	Deflection Left or Right	0	0.039	0	1.0
H2B	Deflection Front or Rear	0	0.051	0	1.0
H4	Feedhole to Bottom of Component	0.7086	0.768	18	19.5
H5	Feedhole to Seating Plane	0.610	0.649	15.5	16.5
L	Defective Unit Clipped Dimension	0.3346	0.433	8.5	11
L1	Lead Wire Enclosure	0.09842	—	2.5	—
P	Feedhole Pitch	0.4921	0.5079	12.5	12.9
P1	Feedhole Center to Center Lead	0.2342	0.2658	5.95	6.75
P2	First Lead Spacing Dimension	0.1397	0.1556	3.55	3.95
T	Adhesive Tape Thickness	0.06	0.08	0.15	0.20
T1	Overall Taped Package Thickness	—	0.0567	—	1.44
T2	Carrier Strip Thickness	0.014	0.027	0.35	0.65
W	Carrier Strip Width	0.6889	0.7481	17.5	19
W1	Adhesive Tape Width	0.2165	0.2841	5.5	6.3
W2	Adhesive Tape Position	.0059	0.01968	.15	0.5

**NOTES:**

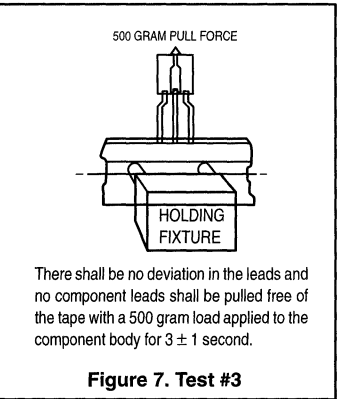
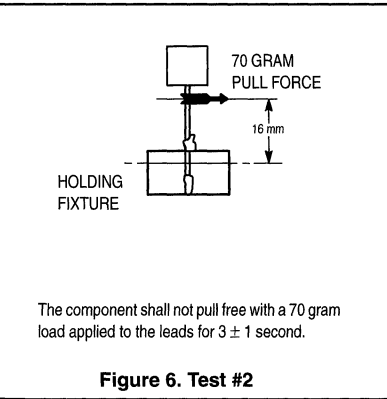
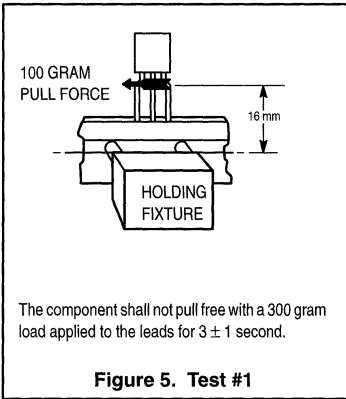
1. Maximum alignment deviation between leads not to be greater than 0.2 mm.
2. Defective components shall be clipped from the carrier tape such that the remaining protrusion (L) does not exceed a maximum of 11 mm.
3. Component lead to tape adhesion must meet the pull test requirements established in Figures 5, 6 and 7.
4. Maximum non-cumulative variation between tape feed holes shall not exceed 1 mm in 20 pitches.
5. Holddown tape not to extend beyond the edge(s) of carrier tape and there shall be no exposure of adhesive.
6. No more than 1 consecutive missing component is permitted.
7. A tape trailer and leader, having at least three feed holes is required before the first and after the last component.
8. Splices will not interfere with the sprocket feed holes.

# TO-92 EIA RADIAL TAPE IN FAN FOLD BOX OR ON REEL

## FAN FOLD BOX STYLES

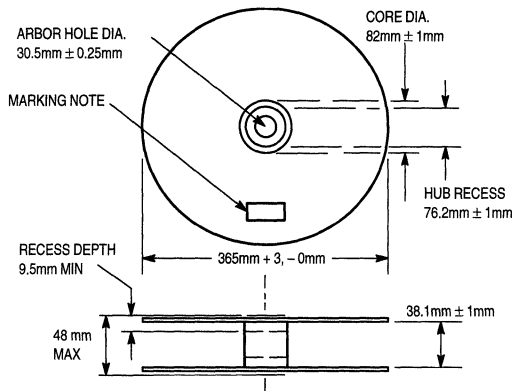


## ADHESION PULL TESTS



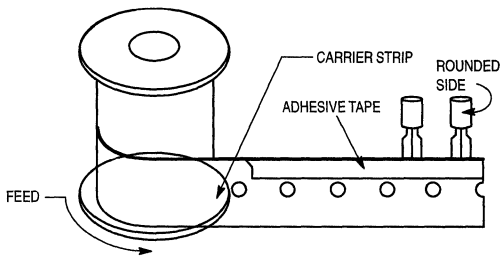
# TO-92 EIA RADIAL TAPE IN FAN FOLD BOX OR ON REEL

## REEL STYLES



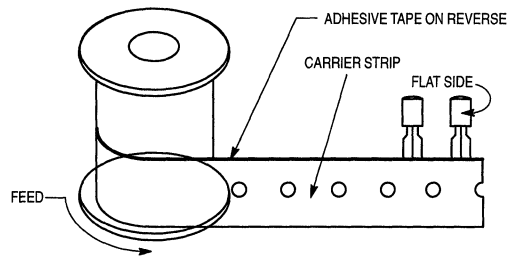
Material used must not cause deterioration of components or degrade lead solderability

**Figure 8. Reel Specifications**



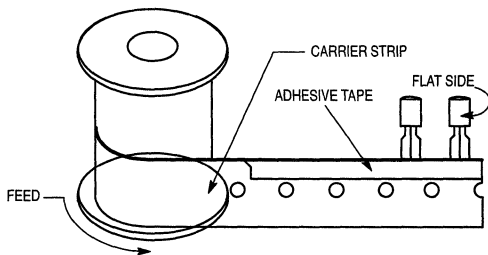
Rounded side of transistor and adhesive tape visible.

**Figure 9. Style A**



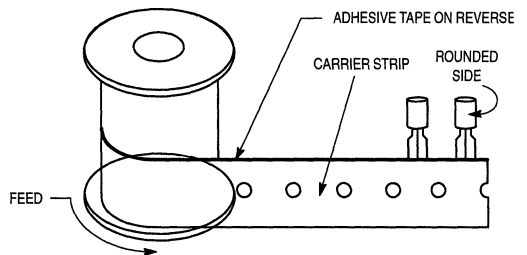
Flat side of transistor and carrier strip visible  
(adhesive tape on reverse side).

**Figure 10. Style B**



Flat side of transistor and adhesive tape visible.

**Figure 11. Style E**



Rounded side of transistor and carrier strip visible  
(adhesive tape on reverse side).

**Figure 12. Style F**



# DO-35, DO-41, Surmetic 30 Radial Tape in Fan Fold Box or On Reel

Radial tape in fan fold box or on reel for axial leaded devices is the best method of capturing devices for automatic insertion in printed circuit boards. These methods of taping are compatible with various equipment for active and passive component insertion.

- Available in Fan Fold Box
- Available on 365 mm Reels
- Accommodates All Standard Inserters
- Allows Flexible Circuit Board Layout
- 2.5 mm Pin Spacing for Soldering

## Ordering Notes:

When ordering radial tape in fan fold box or on reel, specify the style per Figures 4 through 13. Add the appropriate suffix per Tables A and B as listed below:

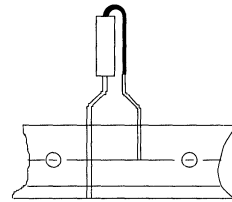
Fan Fold Box Information — Minimum order quantity 1 Box/\$200LL.

Order in increments of 3000.

Reel Information — Minimum order quantity 1 Reel/\$200LL.

Order in increments of 3000.

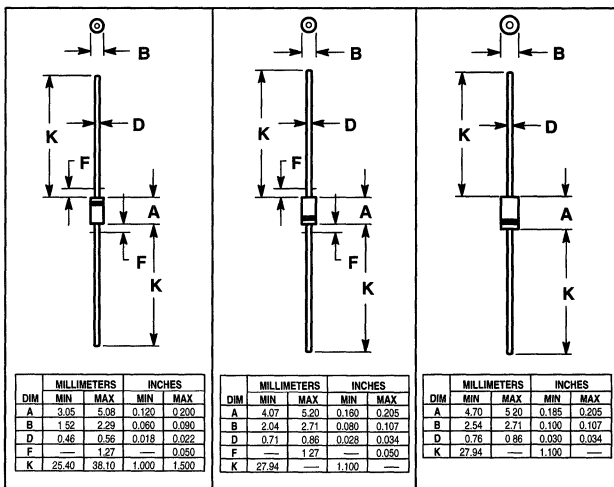
## AXIAL LEADED DEVICE RADIAL TAPE IN FAN FOLD BOX OR ON REEL



CASE 299-02 (DO-35)

CASE 059-03 (DO-41)

CASE 059-01 (Surmetic 30)



## DEVICE TITLE SUFFIX DESIGNATOR TABLE

- RR1 Euroform radial format and reeled per Figures 4, 6, 9, 10. Polarity band up with cathode lead off first.
- RR2 Euroform radial format and reeled per Figures 4, 6, 9, 10. Polarity band down with anode lead off first.
- RB1 Euroform radial lead form with polarity band up per Figures 4, 12 and bulk packed.
- RB2 Euroform radial lead form with polarity band down per Figures 4, 13 and bulk packed.
- RA1 Euroform radial format and ammo packed per Figures 4, 10, 11. Polarity band up with cathode lead off first.
- RA2 Euroform radial format and ammo packed per Figures 4, 10, 11. Polarity band down with anode lead off first.

Table A

## APPLICABLE SUFFIX DESIGNATIONS versus FIGURE OF REFERENCE

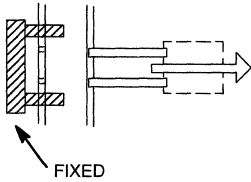
Suffix	Fig. 4	Fig. 5	Fig. 6	Fig. 7	Fig. 8	Fig. 10	Fig. 11	Fig. 12	Fig. 13
RR1	•	•		•	•				
RR2	•			•	•	•			
RB1	•							•	
RB2	•								•
RA1	•	•					•		
RA2	•					•	•		

Table B

# DO-35, DO-41, SURMETIC 30 RADIAL TAPE IN FAN FOLD BOX OR ON REEL

## TESTS

### ADHESIVE POWER STRENGTH TEST



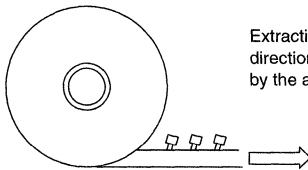
A load of 500 grams, minimum, shall be applied in the direction indicated by the arrow.

### CRITERIA

No deviation in the leads, nor shall the part move

Figure 1

### TAPE EXTRACTION STRENGTH



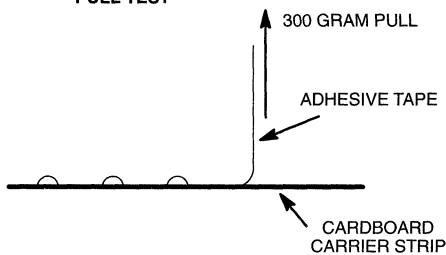
Extraction in the direction indicated by the arrow

### CRITERIA

Tape shall be extracted at a force of not more than 500 grams

Figure 2

### PULL TEST



### CRITERIA

Tape shall withstand a 300-gram pull without being removed from carrier strip.

Figure 3

# DO-35, DO-41, SURMETIC 30 RADIAL TAPE IN FAN FOLD BOX OR ON REEL

## CONFORMAL COATING SPECIFICATION

## EURO FORM RADIAL TAPED

COATING NOT TO INTERFERE WITH SOLDERED LEAD OR DEVICE MARKING

1 – Polarity band up, cathode off first

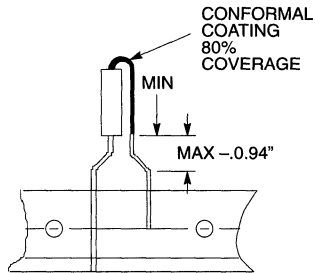


Figure 4

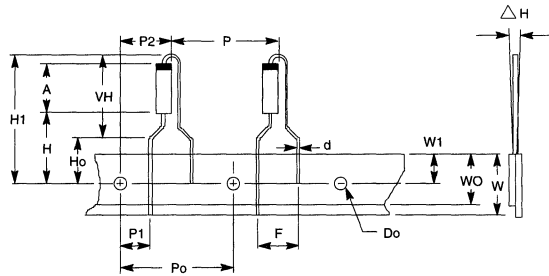


Figure 5

Item	Symbol	Value	Tolerance
Pitch of component	P	12.7	±1.0
Feed hole pitch Cumulative 1.0 mm / 20 pitch	PO	12.7	±0.2
Feed hole center to lead	P1	3.85	±0.7
Lead to lead distance	F	5.0	+8 / -0.2
Component alignment	AH	0	±1.0
Tape width	W	18.0	±0.5
Hold down tape width	W0	12.0	MIN
Hole position	W1	9.0	+0.75 / -0.5
Hole down tape position	W2	0.5	MAX
Height of component to tape center	H	19.5	±1.0
Lead wire clinch height	Ho	16.0	±0.5
Component height	H1	23.25	MAX
Feed hole diameter	Do	4.0	±0.2
Total tape thickness	t	0.7	±0.2
Vertical in board height For case 299-02 only.	VH	10.0	MAX

# DO-35, DO-41, SURMETIC 30 RADIAL TAPE IN FAN FOLD BOX OR ON REEL

REEL ASSEMBLY AND WINDING DIRECTION  
TYPICAL CONSTRUCTION DRAWING ONLY

When the parts are wound onto the housing reel, the interlayer paper shall be used to prevent trouble in rewinding and deviations in the taping dimensions, caused by the parts touching one another.

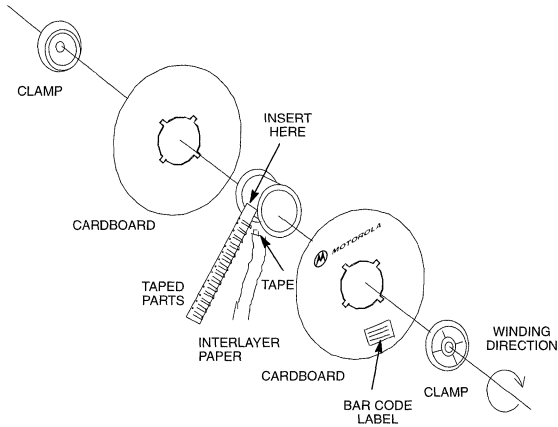


Figure 6

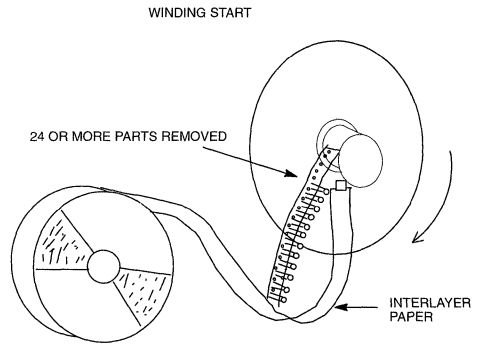


Figure 7

Relative to winding finish, the interlayer paper shall be wound at least once, upon completion of winding. The protective tape shall be wound once on top of the interlayer paper.

REEL DIMENSIONS AND DETAIL

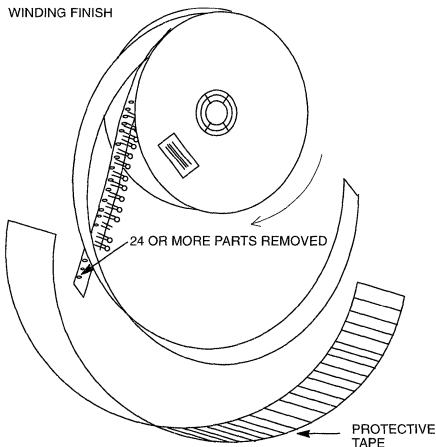


Figure 8

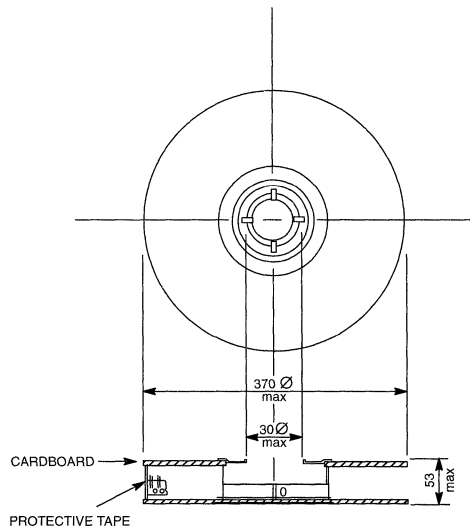


Figure 9

# DO-35, DO-41, SURMETIC 30 RADIAL TAPE IN FAN FOLD BOX OR ON REEL

## EURO FORM RADIAL TAPED

2 – Polarity band down, anode off first

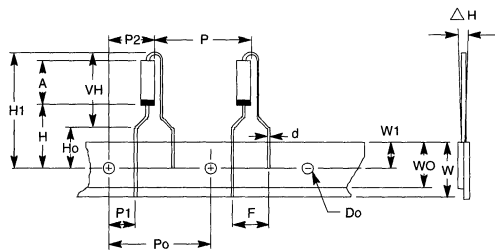


Figure 10

## GENERAL GUIDE FOR PACKAGING IN "AMMUNITION BOXES"

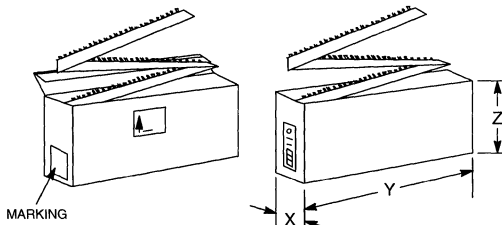


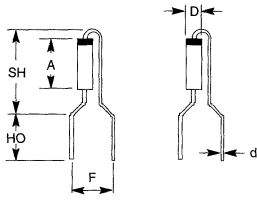
Figure 11

Item	Symbol	Value	Tolerance
Pitch of component	P	12.7	±1.0
Feed hole pitch Cumulative 1.0 mm / 20 pitch	PO	12.7	±0.2
Feed hole center to lead	P1	3.85	±0.7
Lead to lead distance	F	5.0	+8 / -0.2
Component alignment	AH	0	±1.0
Tape width	W	18.0	±0.5
Hold down tape width	W0	12.0	MIN
Hole position	W1	9.0	+0.75 / -0.5
Hole down tape position	W2	0.5	MAX
Height of component to tape center	H	19.5	±1.0
Lead wire clinch height	H0	16.0	±0.5
Component height	H1	23.25	MAX
Feed hole diameter	Do	4.0	±0.2
Total tape thickness	t	0.7	±0.2
Vertical in board height For case 299-02 only.	VH	10.0	MAX

"X"	"Y"	"Z"
1 5/8"	12 1/2"	10"
41 mm	318 mm	254 mm

# DO-35, DO-41, SURMETIC 30 RADIAL TAPE IN FAN FOLD BOX OR ON REEL

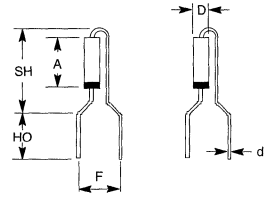
**RB1**  
**POLARITY BAND UP**



**Figure 12**

Item	Symbol	Value (mm)	Tolerance	Value (Inch)	Tolerance
Body Diameter	D	2.7	MAX	0.106	MAX
Body Height	A	5.2	MAX	0.207	MAX
Lead Wire Diameter	d	0.9	MAX	0.035	MAX
Seating Height	SH	10	MAX	0.394	MAX
Lead to Lead Distance	F	5	+1.0/-0.5	0.2	+0.26/-0.02
Lead Wire Clinch Height	HO	5	±0.5	0.2	±0.02

**RB2**  
**POLARITY BAND DOWN**



**Figure 13**

Item	Symbol	Value (mm)	Tolerance	Value (Inch)	Tolerance
Body Diameter	D	2.7	MAX	0.106	MAX
Body Height	A	5.2	MAX	0.207	MAX
Lead Wire Diameter	d	0.9	MAX	0.035	MAX
Seating Height	SH	10	MAX	0.394	MAX
Lead to Lead Distance	F	5	+1.0/-0.5	0.2	+0.26/-0.02
Lead Wire Clinch Height	HO	5	±0.5	0.2	±0.02

# Product Literature and Technical Training

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## In Brief . . .

With the pace of new semiconductor product introductions, the task of providing an effective and up-to-date perspective of available components is beyond the means of any single document. Hence, a comprehensive Motorola Literature System has been put in place to keep semiconductor users totally informed of all aspects of the Motorola product lines — from new product introductions, to applications, to major changes in directions.

The Motorola technical literature library and associated services consist of the following:

- An extensive library of Data Books, each containing a complete selection of data sheets associated with a particular product line.
- A series of User's Manuals and Design Manuals dealing with the application of highly complex products.
- A wide range of Application Notes and Article Reprints detailing the utilization of new and significant products.
- Instructor-led Training for: Digital Signal Processing (DSP) Family; M68000 Family; Embedded Controllers (EC); MC68360 QUIC; PowerPC; Microcontroller (MCU); RISC Family; plus the MC68302, MC68332, MC68340 and the MC68HC16.

These products and services are described on the following pages. However, because of different conditions and standards, some of these may not be available outside the USA.

	<b>Page</b>
Technical Data Services . . . . .	6.1-1
Motorola Semiconductor Master Selection Guide . . .	6.1-1
"IMAGINE" SPS Customer Magazine . . . . .	6.1-1
Mfax — Touch-Tone Fax . . . . .	6.1-1
Internet Server . . . . .	6.1-1
Motorola Data and Application Literature . . . . .	6.1-2
Motorola Application Literature . . . . .	6.1-6
Technical Training . . . . .	6.1-7





# Technical Data Services

## Motorola Semiconductor Master Selection Guide

*For the identification and preliminary selection of components for circuit and system designs*

For the design engineer, the Motorola Master Selection Guide is perhaps the most important single document for the identification and preliminary selection of components for circuit and system designs. Within its pages is a complete listing and description of Motorola semiconductor devices currently in general use, and those recommended for new designs. It serves two purposes:

1. It lists all standard products in the vast Motorola semiconductor inventory for rapid identification.
2. It divides this total product offering into a variety of major product categories, with sufficient technical information to permit an intelligent first-order evaluation as to the most suitable devices for a specific application.

## “IMAGINE” SPS Customer Magazine

*Innovative new developments from Motorola's Semiconductor Products Sector*

This highly informative periodical is available to all semiconductor users on a free subscription basis. The magazine provides information on new semiconductor products and developments and provides a quick-scan insight into new-product offerings. Concise, informative articles discuss significant new product capabilities as well as newly introduced services. In short, it represents an overview of the latest and most important events at Motorola that influence the efficient implementation and most cost-effective use of semiconductor devices.

To receive “IMAGINE” Magazine, in the USA, please contact the Literature Distribution Center by calling 1-800-441-2447.

## Mfax — Touch-Tone Fax

**Mfax** offers access to over 30,000 Motorola documents for faxing to customers worldwide. With menus and voice instruction, customers can request the documents needed using their own touch-tone telephones from any location 7 days a week and 24 hours a day.

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MFAX: RMFAX0@email.sps.com  
or (602) 244-6609  
or 1-800-774-1848 (U.S. and Canada)

## Motorola SPS World Marketing Internet Server

Motorola SPS's Electronic Data Delivery organization has set up a World Wide Web Server to deliver Motorola SPS's technical data to the global Internet community.

Technical data such as the complete Master Selection Guide along with the OEM North American price book are available on the Internet server with full search capabilities. Other data on the server include abstracts of databooks, application notes, selector guides, and textbooks. All have easy text search capability. Ordering Literature from the Literature Distribution Center is available on line.

Other features of Motorola SPS's Internet server include the availability of a searchable press release database, technical training information with on-line registration capabilities, complete on-line access to the MFAX system for ordering faxes, an on-line technical support form to send technical questions and receive answers through email, information on product groups, full search capabilities of device models, a listing of the Domestic and International sales offices, and links directly to other Motorola world wide web servers.

After accessing the Internet, to locate the Motorola SPS World Marketing server, use the following URL:

<http://sps-mot.com>

For more information on Motorola SPS's Internet server you can request BR1307/D from MFAX or request a copy from Literature Distribution Center by calling 1-800-441-2447.

# Motorola Data and Application Literature

*Complete technical data for the world's most comprehensive inventory of semiconductor components*

To complement the industry's broadest line of semiconductor products, Motorola offers a complete library of Data books which detail the electrical characteristics of its products. These documents are supplemented by User's Manuals describing the capabilities of the products in circuit and system design.

Motorola attempts to fill the need for applications information concerning today's highly complex electronic components. Each year dozens of authors from colleges and

universities, and from the industry, add their individual contributions to the collective literature. From these, Motorola has selected a number of texts which add substantially to the comprehension and applications of some of the more complex products. By buying these in large quantities and providing them to customers at lower than retail cost, Motorola hopes to foster a more comprehensive acquaintance with these products at greatly reduced prices.

For complete summaries and prices, order BR101/D from the Literature Distribution Center.

## Data Books and Handbooks

**BR1333/D**, Timing Solutions  
**BR1334/D**, High Performance Frequency Control Products  
**DL110/D**, RF Device Data  
**DL111/D**, Bipolar Power Transistor Data  
**DL118/D**, Optoelectronics Device Data  
**DL121/D**, FAST and LS TTL Data  
**DL122/D**, MECL Device Data  
**DL126/D**, Small-Signal Transistors, FETs and Diodes Device Data  
**DL128/D**, Analog/Interface ICs Device Data  
**DL129/D**, High Speed CMOS Data  
**DL131/D**, CMOS Logic Data  
**DL135/D**, TMOS Power MOSFET Transistor Data  
**DL136/D**, Communications Device Data  
**DL137/D**, Thyristor Device Data  
**DL138/D**, FACT Data  
**DL140/D**, ECLinPS and ECLinPS Lite  
**DL150/D**, TVS/Zener Device Data  
**DL151/D**, Rectifier Device Data  
**DL155/D**, Dynamic RAMs & Memory Modules Data  
**DL156/D**, Fast Static RAM – Component and Module Data  
**DL158/D**, Multimedia Device Data  
**DL159/D**, LonWorks Technology Device Data  
**DL200/D**, Pressure Sensor Device Data  
**DL201/D**, FPGA Data: Field Programmable Gate Arrays  
**HB205/D**, MECL System Design Handbook  
**HB214/D**, Rectifier Applications Handbook  
**HB215/D**, RF Application Reports

## Selector Guides & Application Literature

**BR101/D**, Technical and Applications Literature Catalog  
**BR518/D**, Reliability & Quality Handbook  
**BR729/D**, Motorola 68K Source – Third Party Vendor Catalog  
**BR916/D**, Packaging Manual for ASIC Arrays  
**BR923/D**, Communications, Power & Signal Technologies Group – Reliability Audit Report  
**BR1100/D**, Microprocessor and Memory Technologies Group: Reliability and Quality Report

## Selector Guides & Application Literature (continued)

**BR1112/D**, M68HC05 & M68HC08 Family Customer Specified Integrated Circuit (CSIC) Microcontroller Unit (MCU) Literature  
**BR1133/D**, HIPPO: High-Performance Internal Product Portfolio Overview  
**BR1137/D**, The Motorola Explorer's Guide to the World of Embedded Control Solutions  
**BR1138/D**, 68HC08 – Innovate, Migrate, Accelerate  
**BR1143/D**, Fast Static RAM Cross Reference Guide  
**BR1202/D**, Motorola Quality System Review Guidelines  
**BR1306/D**, CATS – Customer Analysis Tracking System  
**BR1400/D**, OACS (ASIC) – Open Architecture CAD System  
**BR3021/D**, "IMAGINE" Magazine  
**CALCPSTG/D**, Communications, Power and Signal Technologies Group: New Product Calendar  
**CMRQS/D**, CSIC Microcontrollers: Reliability and Quality Monitor Report  
**CR100/D**, Communications, Power and Signal Technologies Group: Through-Hole to Surface Mount Cross Reference  
**CR103/D**, Transient Voltage Suppressors, General Instruments Cross Reference  
**CR104/D**, General Instrument-to-Motorola Optoelectronics Cross Reference  
**DSPNEWSL/D**, DSP News  
**MRQS/D**, Advanced Microcontroller Division: Reliability and Quality Monitor Report  
**SG46/D**, RF Products Selector Guide & Cross Reference  
**SG73/D**, Master Selection Guide  
**SG96/D**, Analog/Interface ICs Selector Guide & Cross Reference  
**SG140/D**, SCANSWITCH Selector Guide  
**SG146/D**, Digital Signal Processors Update  
**SG162/D**, Sensor Products Division  
**SG165/D**, CSIC Microcontrollers Update  
**SG166/D**, Advanced Microcontroller Division Update  
**SG167/D**, High Performance Embedded Systems Fact Sheet  
**SG169/D**, Mixed Signal Solutions from MOS Digital-Analog Integrated Circuits Division

## Motorola Data and Application Literature: (continued)

### Selector Guides & Application Literature (continued)

**SG171/D**, Fast Static RAM Product Update  
**SG172/D**, Dynamic Memory Update  
**SG173/D**, CSIC Microcontrollers: Modular Development Tools  
**SG175/D**, RISC Microprocessor Division: The PowerPC Microprocessor Family  
**SG265/D**, Power MOSFETs Product Update  
**SG266/D**, Bipolar Power Transistors Product Update  
**SG267/D**, Rectifier Product Update  
**SG268/D**, Thyristor Product Update  
**SG271/D**, D<sup>2</sup>PAK Surface Mount Selector Guide  
**SG273/D**, Optoelectronic Operations Selector Guide  
**SG274/D**, Zener Operations Selector Guide  
**SG275/D**, Small-Signal Operations: Surface Mount Packages  
**SG365/D**, Timing Solutions Selector Guide  
**SG367/D**, High-Performance Gate Arrays  
**SG370/D**, Discrete Surface Mount Selector Guide  
**SG375/D**, Silicon Solutions for Motion Control  
**SG417/D**, Semiconductor Products for Wireless Communications  
**SG422/D**, PowerPC Microprocessors Product Overview  
**SG423/D**, TIGER: The Integrated Guide to European RAMs  
**SG424/D**, EAGLES: European Analog Guide for Leading & Emerging Systems  
**SG425/D**, Lamp Ballast Selector Guide  
**SG426/D**, DINO: Discrete Innovation News Overview

### User's Manuals

**ADCRM/AD**, Analog-to-Digital Converter Reference Manual  
**CPU08RM/AD**, M68HC08 Central Processor Unit Reference Manual  
**CPU16RM/AD**, M68HC16 Family Reference Manual  
**CPU32RM/AD**, CPU32 Central Processor Unit Reference Manual  
**CTMRM/D**, Configurable Timer Module Reference Manual  
**DSP56KFAMUM/AD**, DSP56000 Digital Signal Processor Family Manual  
**DSP56000UM/AD**, DSP56000/DSP56001 Digital Signal Processor User's Manual  
**DSP56002UM/AD**, DSP56002 Digital Signal Processor User's Manual  
**DSP56003UM/AD**, DSP56003/005 Digital Signal Processor User's Manual  
**DSP56004UM/AD**, DSP56004 Digital Signal Processor User's Manual  
**DSP56100FM/AD**, DSP56100 Digital Signal Processor Family Manual  
**DSP56156UM/AD**, DSP56156 Digital Signal Processor User's Manual  
**DSP56166UM/AD**, DSP56166 Digital Signal Processor User's Manual

### User's Manuals (continued)

**DSP56300FM/AD**, DSP56300 24-Bit Digital Signal Processor Family Manual  
**DSP56301UM/AD**, DSP56301 24-Bit Digital Signal Processor User's Manual  
**DSP96002UM/AD**, DSP96002 IEEE Floating-Point Dual-Port Processor User's Manual  
**GPTRM/AD**, Modular Microcontroller Family General Purpose Timer Reference Manual  
**H4CDM/D**, H4C Series Design Reference Guide  
**H4CPDM/D**, H4CPLUS Series Design Reference Guide  
**HC711D3PGMR/AD1**, M68HC711D3PGMR Programmer Board User's Manual  
**HDCDM/D**, HDC Series Design Reference Guide  
**LONUG/AD**, LonBuilder User's Guide  
**LP2/D**, Portable Power: The Competitive Edge of the 68HC11 – Low Power Design Guidebook  
**M5CDM/D**, M5C Series Design Reference Guide  
**M68CPU32BUG/D**, CPU32BUG Debug Monitor User's Manual  
**M68HC05AG/AD**, M68HC05 Applications Guide  
**M68HC08RG/AD**, HC08 Family Reference Guide  
**M68HC11EVB/D1**, M68HC11EVB Evaluation Board User's Manual  
**M68HC11EVBU/AD2**, M68HC11EVBU Universal Evaluation Board User's Manual  
**M68HC11EVM/AD8**, M68HC11EVM Evaluation Module User's Manual  
**M68HC11RM/AD**, M68HC11 Reference Manual  
**M68PCBUG11/D2**, M68HC11 PCbug11 User's Manual  
**M68PRM/D**, M6800 Programming Reference Manual  
**M6809PM/AD**, MC6809–MC6809E Microprocessor Programming Manual (1981)  
**M68000PM/AD**, M68000 Family Programmer's Reference Manual  
**M68000UM/AD**, M68000 8-/16-/32-bit Microprocessors User's Manual, Ninth Edition  
**M68020UM/AD**, MC68020/MC68EC020 Microprocessors User's Manual  
**M68040UM/AD**, MC68040, MC68040V, MC68LC040, MC68EC040, MC68EC040V Microprocessors User's Manual  
**M68060UM/AD**, MC68060, MC68LC060, MC68EC060 Microprocessors User's Manual  
**M68332EVKEM/AD1**, M68332EVK Evaluation Kit Exercise Manual  
**MC68EC030UM/AD**, MC68EC030 32-bit Embedded Controller User's Manual  
**MC68F333UM/AD**, MC68F333 User's Manual  
**MC68HC05CxRG/AD**, MC68HC05Cx HCMOS Single-Chip Microcontrollers Programming Reference Guide  
**MC68HC11A8RG/AD**, MC68HC11A8 Programming Reference Guide  
**MC68HC11C0RG/AD**, MC68HC11C0 Programming Reference Guide

## Motorola Data and Application Literature: (continued)

### User's Manuals (continued)

**MC68HC11D3RG/AD**, MC68HC11D3/MC68HC711D3  
Programming Reference Guide

**MC68HC11ERG/AD**, MC68HC11E Programming  
Reference Guide

**MC68HC11F1RG/AD**, MC68HC11F1 Programming  
Reference Guide

**MC68HC11K4RG/AD**, MC68HC11K4/MC68HC711K4  
Programming Reference Guide

**MC68HC11KA4RG/AD**, MC68HC11KA4/MC68HC711KA4  
Programming Reference Guide

**MC68HC11L6RG/AD**, MC68HCL6/MC68HC711L6  
Programming Reference Guide

**MC68HC11MRG/AD**, M68HC11 M Series Programming  
Reference Guide

**MC68HC11NRG/AD**, MC68HC11N Series Programming  
Reference Guide

**MC68HC16Y1UM/AD**, MC68HC16Y1 User's Manual

**MC68HC16Z2UM/AD**, MC68HC16Z2 User's Manual

**MC68MH360RM/AD**, MC68MH360 QUICC32 Quad  
Integrated Multichannel Controller Reference Manual

**MC68030UM/AD**, MC68030 Enhanced 32-bit MPU User's  
Manual, third edition

**MC68302UM/AD**, MC68302 Integrated Multiprotocol  
Processor User's Manual

**MC68306UM/AD**, MC68306 Integrated EC000 Processor  
User's Manual

**MC68307UM/AD**, MC68307 Integrated Multiple-Bus  
Processor User's Manual

**MC68322UM/AD**, Bandit: MC68322 Integrated Printer  
Processor User's Manual

**MC68328UM/AD**, MC68328 (Dragonball) Integrated  
Processor User's Manual

**MC68330UM/AD**, MC68330 Integrated CPU32 Processor  
Users Manual

**MC68331UM/AD**, MC68331 User's Manual

**MC68332UM/AD**, MC68332 User's Manual

**MC68340UM/AD**, MC68340 Integrated Processor User's  
Manual

**MC68341UM/AD**, MC68341 Integrated Processor User's  
Manual

**MC68349UM/AD**, MC68349 High Performance Integrated  
Processor User's Manual

**MC68356UM/AD**, MC68356 Signal Processing  
Communications Engine User's Manual

**MC68360UM/AD**, MC68360 Quad Integrated  
Communications Controller User's Manual

**MC68488UM/AD**, MC68488 General Purpose Interface  
Adapter User's Manual

**MC68605UM/AD**, MC68605 X.25 Protocol Controller User's  
Manual

**MC68606UM/AD**, MC68606 Multi-Link LAPD Protocol  
Controller User's Manual

**MC68824UM/AD**, MC68824 Token Bus Products User's  
Manual

**MC68836UM/AD**, MC68836 FDDI User's Manual

**MC68837UM/AD**, MC68837 FDDI User's Manual

**MC68838UM/AD**, MC68838 FDDI User's Manual

**MC68839UM/AD**, MC68839 FDDI System Interface User's  
Manual

**MC68840UM/AD**, MC68840 Integrated Fiber Distributed  
Data Interface User's Manual

**MC68847UM/AD**, MC68847 Quad ELM FDDI User's  
Manual

**MC68851UM/AD**, MC68851 Paged Memory Management  
Unit User's Manual, second edition

**MC68881UM/AD**, MC68881/MC68882 Floating-Point  
Coprocessor User's Manual, second edition

**MC88100UM/AD**, MC88100 RISC Microprocessor User's  
Manual

**MC88110/410DH/AD**, MC88110/MC88410 Designer's  
Handbook

**MC88110UM/AD**, MC88110 Second Generation RISC  
Microprocessor User's Manual

**MC88200UM/AD**, MC88200 Cache/Memory Management  
Unit User's Manual

**MC88410UM/AD**, MC88410 Secondary Cache Controller  
User's Manual

**MC92005UM/D**, MC92005 SBus Slave Interface Controller  
User's Manual

**MCCIRM/AD**, Multichannel Communication Interface  
Reference Manual

**MCF5102UM/AD**, MCF5102 ColdFire User's Manual  
**MCF5200PRM/AD**, ColdFire Programmer's Reference  
Manual

**MCUDEVTLDIR/D**, Motorola Microcontroller Development  
Tools Directory

**MPCFPE/AD**, PowerPC Microprocessor Family: The  
Programming Environments

**MPCTOOLBK/AD**, PowerPC Tools – Development Tools  
for PowerPC Microprocessors

**MPC105UM/AD**, PowerPC PCI Bridge/Memory Controller  
User's Manual

**MPC601UM/AD**, PowerPC 601 – RISC Microprocessor  
User's Manual

**MPC603eUM/AD**, PowerPC 603e RISC Microprocessor  
User's Manual

**MPC604UM/AD**, PowerPC 604 RISC Microprocessor  
User's Manual

**QSMRM/AD**, Queued Serial Module Reference Manual

**RCPURM/AD**, MPC500 Family: RCPU Reference Manual

**SCIMRM/AD**, Single-Chip Integration Module Reference  
Manual

**SIMRM/AD**, System Integration Module Reference Manual

**SIURM/AD**, MPC500 Family: System Integration Unit  
Reference Manual

**TIM08RM/AD**, TIM08 Timer Interface Module Reference  
Manual

**TPURM/AD**, M68300 Family Time Processor Unit  
Reference Manual

## Motorola Data and Application Literature: (continued)

### Textbooks

**TB301/D**, Basic Microprocessors and the 6800  
**TB304/D**, Pascal Programming Structures for Motorola Microprocessors  
**TB309/D**, Programming the 6809  
**TB312/D**, Introduction to Integrated Circuit Layout  
**TB323/D**, The 68000 Book  
**TB329/D**, Sensor Technology and Devices  
**TB333/D**, Signal Processing, Image Processing and Graphics Applications with Motorola's DSP96002 Processor. Volume I: Signal Processing  
**TB334/D**, Signal Processing, Image Processing and Graphics Applications with Motorola's DSP96002 Processor. Volume II: Image Processing and Graphics Applications  
**TB335/D**, The PowerPC Architecture: A Specification for a New Family of RISC Processors

### Textbooks (continued)

**TB336/D**, Automotive Electronics Handbook  
**TB337/D**, PowerPC Programming for Intel Programmers  
**TB338/D**, PowerPC Microprocessor Common Hardware Reference Platform  
**TB339/D**, Understanding Smart Sensors

### Technical Data Services

**DK105/D**, Scattering Parameter Library  
**DK106/D**, Scattering Parameter Plotting Utility  
**DK107/D**, Impedance Matching Program  
**DK202/D**, Spice Disk for AN1043/D 3.5 (Mac)  
**DK301/D**, Spice Disk for AN1043/D 3.5 (MS-DOS)  
**DK305/D**, PLL Frequency Planning  
**DK306/D**, PLL Lock-in Time Analysis  
**SG73/D**, Master Selection Guide  
**SEMIVID/D**, Basic Semiconductor Videos  
Dr. BuB, DSP Electronic Bulletin Board Freeware Line,  
Microcontroller Electronic Bulletin Board

# Motorola Application Literature

## *Semiconductors in theory and practice*

Application Notes, Engineering Bulletins and Article Reprints are part of a total information system to define the characteristics and applications of semiconductor devices. Motorola's library consists of more than 300 such documents dealing with the applications of all types of semiconductors from discrete power transistors to the most complex microprocessors. All are described in an Application Note Catalog available from our Literature Distribution Center.

Individual application notes, application reports,

engineering bulletins and article reprints can also be ordered from our Literature Distribution Center.

Contact the Literature Distribution Center for prices and ordering information. In addition, there may be an alternative document available in some countries, contact your local Motorola Sales Office.

For complete summaries: order BR101/D from the Literature Distribution Center.

# Motorola Technical Training Courses

Dear Customer:

Our primary goal as an organization is to enhance the designer's effectiveness in implementing Motorola's offering of microprocessors and microcontrollers. This is accomplished by providing our customers with formalized training, including application examples reinforced with hands-on labs, to empower the designer with the tools to efficiently accomplish their design.

Teaming with our training partners, Ascent Technologies and Arnewsh, Inc., we continue to strive for excellence in our offering of quality instruction in the application of Motorola products. Motorola's Technical Training organization develops new training courses in cooperation with our applications engineers and product marketing resources very early in the new product cycle, thus assuring vital and timely training to assist with your design. We then certify our training partners to assure the best possible training experience for engineers/programmers.

Our technical training is structured to offer the best instruction in the semiconductor industry, and we look forward to providing training that will adequately serve your design and application needs.

Thank you for choosing Motorola.

Jay Nunez  
Director  
Technical Operations

Sherril A. Harmon  
Manager  
Technical Training

## **We can bring the training to your facility!**

Courses listed in this brochure can be taught at your facility and can be tailored to fit your needs. For details and information please call one of the training providers: Motorola Technical Training (602) 302-8008, Arnewsh, Inc. (970) 223-1616, or Ascent Technologies (800) 410-3601.

## Motorola Technical Training Courses (continued)

### DSP561xx Family Microprocessor

**Description:** This is a four–day course in which the student (with digital signal processing design experience) learns to design with the DSP561xx digital signal processor. The course consists of lectures, labs, and exercises.

**Prerequisites:** The student must have knowledge of at least one microprocessor and its assembly language. A prior understanding of digital signal processing theory is important for those whose applications are DSP oriented.

### DSP5600x Family Microprocessor (with intro to DSP563xx/6xx)

**Description:** This is a five–day course in which the student (with digital signal processing design experience) learns to design with the DSP5600x digital signal processor. The course consists of lectures, labs, and exercises.

**Prerequisites:** The student must have knowledge of at least one microprocessor and its assembly language. A prior understanding of digital signal processing theory is important for those whose applications are DSP oriented.

### DSP563xx/6xx Family Digital Signal Processor

**Description:** This is a two or four–day course in which the student (with digital signal processing design experience) learns to design with the DSP563xx/6xx digital signal processor. Students who have DSP5600x experience may choose to attend the last two days only. The course consists of lectures, labs, and exercises.

**Prerequisites:** The student must have knowledge of at least one microprocessor and its assembly language. A prior understanding of digital signal processing theory is important for those whose applications are DSP oriented.

### DSP568xx Family Digital Signal Processor

**Description:** This is a four–day course in which the student (with digital signal processing design experience) learns to design with the DSP568xx digital signal processor. The course consists of lectures, labs, and exercises.

**Prerequisites:** The student must have knowledge of at least one microprocessor and its assembly language. A prior understanding of digital signal processing theory is important for those whose applications are DSP oriented.

### DSP96002 Microprocessor

**Description:** This course prepares the student for designing systems which include the DSP96002. The course consists of four days of lecture.

**Prerequisites:** This course assumes no prior knowledge of the DSP56001 device.

### MC68HC05/08 Microcontroller

**Description:** This is a four–day introductory course to the 68HC08 microcontroller family. This course covers the major modules of the 68HC08 including discrete I/O, timer functions, serial communications interfaces, multiplex communications modules, and the exception related modules. Many application examples are included. If needed, or if the actual target platform is the HC05, there is one–day (optional) added to the beginning of the class.

**Prerequisites:** No prior MC68HC08 knowledge is assumed. Some basic understanding of embedded system operations and their target applications is helpful.

### MC68HC11 Microcontroller Family

**Description:** This is a four–day introduction to the MC68HC microcontroller family which covers major features of this industry–standard microcontroller. Students will understand how to program and apply all the major subsystems of the MC68HC11 including discrete I/O, timer functions, serial communication interfaces, analog to digital conversion, and the computer operating properly (COP) watchdog timer. Many application examples are included.

**Prerequisites:** Students should have a basic understanding of embedded system operations and their target application.

### MC68HC12 Microcontroller

**Description:** This three–day course is designed to help the student understand the MC68HC12 family and their applications. The student will write I/O routines to configure an entire system to meet application requirements.

Applications such as angle base engine control, anti–skid breaking system and serial communication will be discussed in detail.

**Prerequisites:** 8 or 16–bit microcontroller knowledge and design experience will be helpful.

### MC68HC16 Microcontroller Family

**Description:** This is a four–day course in which the MC68HC16 family major features are covered, including the CPU16, general purpose timer, and analog–to–digital converter. In addition, the system integration module, single–chip integration module, queued serial module, standby RAM, multi–channel communications interface, and time processor unit will be covered. Lecture, labs and exercises are a major part of the learning process for this course.

**Prerequisites:** Knowledge of microprocessor fundamentals. Previous experience with either MC68HC05 or MC68HC11 is helpful.



## Motorola Technical Training Courses (continued)

### MC68332 Embedded Controller

**Description:** This is a five–day intensive introduction to the MC68332 embedded controller family. Students will understand how to program and apply all the major subsystems of the 68332, including discrete I/O, timer functions, serial communication interfaces, analog to digital conversion, computer operating properly (COP) watchdog timer. Many application examples are included.

**Prerequisites:** Students should have a basic understanding of embedded system operations and their target application.

### MC68376 Microcontroller

**Description:** This is a five–day intensive introduction to the MC68376 microcontroller. Students will understand how to program and apply all the major sub–systems of the 68376, including discrete I/O, time processor unit, the configurable timer module, the queued analog to digital converter, the queued serial module, and the Toucan module. Application examples are included.

**Prerequisites:** Students should have a basic understanding of embedded systems operations and their target application.

### ANSI C for Embedded Systems

**Description:** This four–day course is a fast–paced introduction to programming Motorola microcontrollers using the C language. The course covers all essential C language constructs their typical implementation on Motorola microcontrollers and how to strategically design embedded system C software. Particular attention is paid to unique embedded system issues such as compiler ROM and RAM usage and throughput minimization. Hands–on lab exercises reinforce all major topics and use commercially available cross–compilers and simulators.

**Prerequisites:** Students should have a basic understanding of the 68HC11 or 68332 microcontroller and embedded systems operation. No familiarity with C is assumed.

### MC68EC/000 Microprocessor

**Description:** This is a four–day course which covers both the software and hardware aspects of the MC68EC/000 processor. The course will cover programming model, data types, instruction set, addressing modes, exception processing, signal function and characteristics.

**Prerequisites:** A basic understanding of microprocessor systems, digital logic and memory concepts is required.

### MC68EC/000 Family Programming

**Description:** This is a three–day course which presents the software functionality of all the MC68/EC0x0 microprocessors. The course covers the programming model, data types,

instruction set, addressing modes, exception processing, and an overview of the caches and memory management unit in 020/030/040. The course consists of lectures, exercises, and labs.

**Prerequisites:** A basic understanding of microprocessor systems and assembly language is required.

### MC68EC/040/060 Microprocessors

**Description:** This is a two–day course which covers all the hardware and system aspects of both the MC68040 and MC68060 members. The first one and a half days is used to cover the MC68040 and the common issues of the MC68060. The last half day is used to point out MC68060 differences and the new features.

**Prerequisites:** Students should have complete familiarity with the software aspects of the M68K family. Students who also need the software and programming background may attend the M68K family programming course offered in the same week.

### MC68302 Integrated Multiprotocol Processor

**Description:** This is a four–day course in which students learn to design and write programs for the various chip submodules. This includes the MC68000 core, communication processor (CP) and system integration block (SIB). The course consists of lectures, exercises, and labs.

**Prerequisites:** Students need the software and hardware understanding of the MC68000 processor.

### MC68360 QUICC–QUad Integrated Communication Controller

**Description:** This is a four–day course in which students learn to design and write programs for the various chip modules. This includes the CPU32+ core, communication processor module (CPM) and system integration module (SIM60). Labs are a major part of the learning process; lecture and exercises are also a part of the course.

**Prerequisites:** To benefit most from the course, a S/W and H/W understanding of the MC68000 microprocessor is a requirement.

### MC6834x Family Integrated Processor ('330, '340, '341, '349)

**Description:** This is a three–day course in which students will learn to design with the CPU32/CPU32+, DMA channels, timers, serial I/O modules, and system integration module. The course consists of lectures, exercises, and labs.

**Prerequisites:** Students need the software and hardware understanding of the M68K processor family.

## Motorola Technical Training Courses (continued)

### PowerPC™ 6xx Family Microprocessor

**Description:** The MPC6xx is primarily targeted for the desktop marketplace. The PowerPC™ MPC6xx course is a four-day course that details all publicly announced MPC6xx implementations such as the MPC602, MPC603 and MPC604. This course contains lectures, labs, and exercises.

**Prerequisites:** The student must have advanced microprocessor and assembly language knowledge. An understanding of memory management, multi-processing/master, and cache concepts is also beneficial.

### MPC505 PowerPC™ Microcontroller

**Description:** This is a three-day course in which the student learns to design with the embedded PowerPC™ core, system integration unit (SIU), and associated components of the MPC505. The course consists of lectures and exercises.

**Prerequisites:** The student must have advanced microprocessor and assembly language knowledge. PowerPC™ experience is not required.

### MPC821 PowerPC™ Integrated Microcontroller

**Description:** This is a four-day course in which the student learns to design with the MPC821, i.e. the embedded PowerPC™ core, and the enhanced communications processor module. The course will contain lectures, labs, and exercises.

**Prerequisites:** The student must have advanced microprocessor and assembly language knowledge. The first day of this course is optional, intended for designers with no PowerPC™ background.

### MPC860 Power QUICC–QUad Integrated Communication Controller

**Description:** This is a four-day course in which students learn to design and write programs for the various chip submodules. This includes the embedded PowerPC™ Core, the RISC communication processor module (CPM), and system integration unit. Labs are a major part of the learning process; lectures and exercises are also a part of the course.

**Prerequisites:** To benefit most from the course, some S/W and H/W understanding of the PowerPC™ RISC processor is a requirement. However, if students do not have this requirement, the first day is a must to attend. The first day will cover PowerPC™ basics and fundamentals.

### TPU Microcode

**Description:** The TPU Microcode course is a three-day lab-intensive course in which the student learns how to write microcode functions for the TPU. The course is approximately 50% lecture and exercises and 50% lab time.

**Prerequisite:** The student must have advanced microprocessor experience.

### ColdFire MCF5200

**Description:** This is a three-day course that covers the ColdFire family of microprocessors. This “variable length” RISC MPU is contrasted with traditional RISC and CSIC architectures, and the advantages of the ColdFire family are highlighted.

The software portion of this course covers the programming model, addressing modes, and instruction set. Code density, exception processing and program examples are also reviewed.

The hardware portion begins with the system integration module (SIM). The SIM includes the external bus interface and timing, chip select operation, DRAM controller, and system protection features.

The hardware portion also covers in detail the on-board debug module. The course will demonstrate to the student how to debug application programs using the advanced features of the background debug mode (BDM), including real-time trace and hardware breakpoints.

This course also covers the other ColdFire family resources, including on-chip caches, timers, uarts and the M-bus interface.

Each hardware topic includes a lab session and an application example is provided to insure the student has a clear understanding of the features of the ColdFire family.

**Prerequisite:** 32, 16 or 8-bit microprocessor/microcontroller knowledge or design experience.

## Motorola Technical Training Courses (continued)

For information regarding the following courses, call (800) 262-5486. RTEK support and course information offered by Embedded System Product, Inc.

Please call (800) 262-5486 to speak with the RTEK Training Coordinator concerning course pricing, enrollment, or on-site training.

### Use of the RTEK Kernel

**Description:** This is a three-day course in which the student receives an in-depth presentation of the RTEK kernel with reinforcement from extensive "hands-on" usage. The course covers all aspects of RTEK kernel usage beginning with an overview of real-time software architectures, a presentation of RTEK features, its kernel objects and services, system configuration and generation, and interrupt servicing concepts for device drivers. Lecture time is interspersed with lab exercises to achieve maximum benefit for the student. Each day ends with a question and answer session to cover application topics or items of special interest to the student.

**Prerequisites:** Prior knowledge or use of a real-time kernel

is not required but will benefit the student. Students should be familiar with the C language and a source level debugger.

### RTEK Training Class Dates for 1997

**January 14-16**

**February 11-13**

**March 18-20**

**April 8-10**

**May 13-15**

**June 17-19**

**July 15-17**

**August 12-14**

**September 16-18**

**October 14-16**

**November 11-13**

**December** (No Scheduled Class)

All scheduled classes are held in Houston, TX at the Embedded System Products Training Center. Closed classes are available on-site by special arrangement.

# Training Providers and Their Schedules

Please call one of the training providers above for details on providing classes at your facility

## MOTOROLA Courses and Locations

Motorola Technical Training Center • 432 North 44th Street • Suite 175 (Classroom) • Phoenix, Arizona 85008  
Call (602) 302-8008 for class pricing

### FAX REGISTRATION FORM FAX (602) 302-8025

Please mark the class you will be attending and fax to **ATTENTION: REGISTRAR.**

- |  |   |   |
|--|---|---|
| <input type="checkbox"/> DSP568xx, Phoenix, January 28 | <input type="checkbox"/> DSP563xx/6xx, Phoenix, February 18 | <input type="checkbox"/> MC68HC12, Phoenix, February 11 |
| <input type="checkbox"/> DSP568xx, Phoenix, March 11   | <input type="checkbox"/> DSP563xx/6xx, Ann Arbor, April 22  | <input type="checkbox"/> MC68HC12, Phoenix, March 4     |
| <input type="checkbox"/> DSP568xx, Ann Arbor, May 6    | <input type="checkbox"/> DSP563xx/6xx, Ann Arbor, June 17   | <input type="checkbox"/> MC68HC12, Phoenix, May 6       |

You can also register for Motorola taught courses by:

**Email:** [R17994@email.sps.mot.com](mailto:R17994@email.sps.mot.com)

**Internet WWWeb, URLs:**

**Internal:** <http://design-net.sps.mot.com/training/catalog/training.html>

**External:** <http://design-net.com/training/catalog/training.html>

Plan early as classes fill up rapidly and space is limited.

## ARNEWSH, INC. Courses and Locations

P.O. Box 270352 • Fort Collins, Colorado 80527-0352 • (970) 223-1616  
Call for class pricing

### FAX REGISTRATION FORM FAX (970) 223-9573

Please mark the class you will be attending and fax to **ATTENTION: REGISTRAR.**

- |  |  |   |
|--|--|---|
| <input type="checkbox"/> PowerPC™ 6xx, Phoenix, January 28   | <input type="checkbox"/> MC68302, Denver, April 8      | <input type="checkbox"/> MPC860, San Jose, June 10                        |
| <input type="checkbox"/> PowerPC™ 6xx, Phoenix, April 29     | <input type="checkbox"/> MC68360, Phoenix, February 18 | <input type="checkbox"/> MPC821, Phoenix, March 11                        |
| <input type="checkbox"/> PowerPC™ 6xx, San Jose, June 24     | <input type="checkbox"/> MC68360, San Jose, May 20     | <input type="checkbox"/> MC68EC/000, Denver, February 25                  |
| <input type="checkbox"/> MCF520x ColdFire, Phoenix, March 25 | <input type="checkbox"/> MPC860, Phoenix, January 14   | <input type="checkbox"/> MC68EC/000 Family Programming,<br>Chicago, May 5 |
| <input type="checkbox"/> MC6834x, Denver, March 18           | <input type="checkbox"/> MPC860, Seattle, April 22     | <input type="checkbox"/> MC68EC/040/060, Chicago, May 8                   |

## ASCENT TECHNOLOGIES Courses and Locations

525 Avis Drive, Suite 15 • Ann Arbor, MI 48108 • (800) 410-3601  
Call for class pricing

### FAX REGISTRATION FORM FAX (313) 668-2735

Please mark the class you will be attending and fax to **ATTENTION: REGISTRAR.**

- |  |   |  |
|--|---|--|
| <input type="checkbox"/> MC68HC11, Ann Arbor, March 11 | <input type="checkbox"/> MC68376, Phoenix, January 20       | <input type="checkbox"/> DSP5600x, Ann Arbor, June 2           |
| <input type="checkbox"/> MC68HC11, Ann Arbor, June 10  | <input type="checkbox"/> MC68376, Ann Arbor, March 17       | <input type="checkbox"/> TPU Microcode, Ann Arbor, February 25 |
| <input type="checkbox"/> MC68HC16, Ann Arbor, March 4  | <input type="checkbox"/> MC68376, Ann Arbor, April 28       | <input type="checkbox"/> ANSI C, Ann Arbor, January 21         |
| <input type="checkbox"/> MC68HC16, Ann Arbor, April 29 | <input type="checkbox"/> MC68HC05/HC08, Phoenix, February 3 | <input type="checkbox"/> ANSI C, Ann Arbor, February 18        |
| <input type="checkbox"/> MC6833x, Phoenix, February 24 | <input type="checkbox"/> MC68HC05/HC08, Ann Arbor, April 14 | <input type="checkbox"/> ANSI C, Ann Arbor, April 8            |
| <input type="checkbox"/> MC6833x, Ann Arbor, May 12    | <input type="checkbox"/> DSP5600x, Phoenix, February 10     | <input type="checkbox"/> ANSI C, Ann Arbor, May 20             |
| <input type="checkbox"/> MC6833x, Ann Arbor, June 16   | <input type="checkbox"/> DSP5600x, Phoenix, March 24        |  |

**Call 1-800-774-1848 or 602-244-6609 to have the latest copy  
of our Technical Training Catalog and class schedule faxed to you.  
If you are outside of the USA, call your local Technical Training Center  
or Sales Office and ask for BR348/D.**

## Technical Training Centers

### Regional Training Centers

#### Detroit

41700 Six Mile Road  
Nothville, MI 48167  
(313) 347-6800

#### Phoenix

432 N 44th Street  
Phoenix, AZ 85008  
(602) 302-8008

### International Training Centers

#### Munich, Germany

(49)-89-92103571

#### Velizy Villacoublay Cedex, France

(33)-1-34635894

#### Aylesbury, United Kingdom

(44)-1296-380304

### Provide the following information when registering:

**You can also register by:**

**Email: R17994@email.sps.mot.com**

**Internet WWWeb, URL: http://Design-NET.com**

#### MOTOROLA

Technical Training • 432 North 44th Street • Suite 200 • Phoenix, AZ 85008

Voice: (602) 302-8008 • FAX: (602) 302-8025

#### ATTENTION: REGISTRAR

Contact's Name: \_\_\_\_\_ Email: \_\_\_\_\_ Fax Number: \_\_\_\_\_

Contact's Phone Number: \_\_\_\_\_ Company: \_\_\_\_\_

Street Address: \_\_\_\_\_ City: \_\_\_\_\_ State/Province: \_\_\_\_\_ Zip/Postal Code: \_\_\_\_\_

1. \_\_\_\_\_  
Student's Name/Email Address Phone Fax

\*Mail Stop \*SS# \*Dept.# \*Badge# \*Sector

2. \_\_\_\_\_  
Student's Name/Email Address Phone Fax

\*Mail Stop \*SS# \*Dept.# \*Badge# \*Sector

3. \_\_\_\_\_  
Signature of Authorizing Manager Email Phone

\*Required for all Motorola employees only

<ul style="list-style-type: none"> <li>• Intended method of payment: Charge Card <input type="checkbox"/> Purchase Order <input type="checkbox"/> Check <input type="checkbox"/></li> <li>• Motorolan's: Dept. # _____</li> </ul>
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**Students will be contacted to confirm receipt of faxed registration and method of payment.**



# Device Index and Subject Index

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## In Brief . . .

### Device Index

The following index lists the device numbers of the products contained in this selector guide and references the page number where each device is described in greater detail.<sup>(1)</sup> The listing is in a numeric sequence organized in a "computer sort." This means that all the devices listed herein follow a 39 character alphabet. This "new" alphabet starts with a Period, a Dash and a Slash (. - /), followed by the 26 letter alphabet (A thru Z), which is then followed by 10 numbers (0 thru 9).

The ranking or hierarchy of this 39 character alphabet is as follows:

. - / A B C D E F G H I J K L M N O P Q R S T U V W X  
Y Z 0 1 2 3 4 5 6 7 8 9

Therefore, if you are looking for a device starting with a letter of the alphabet like an MC1741CP, it would appear before a device starting with a number, such as 2N1132.

To find a device in this index, start with the first character of the device and find that section of the index; next move to the second character in the device number, and move to that character within the same portion of the listing; and so on until the device number is found. In other words, it is used just like a dictionary, character by character.

For example, to find the 2N6837, go to that section of the listing that begins with the number "2" (Notice that the section follows all devices that begin with a letter of the alphabet or "1"). Next, find that portion of the listing that begins with "2N" (Notice it follows those devices that begin with "2K"). Next, find that portion of the listing that begins with "2N6" (Notice it follows those devices that begin with "2N5"). Continue looking for those portions that begin with the next consecutive character until you have found the entire number.

Because of the way "Computer Sort" works it is not necessary to be concerned with the absolute value or number of characters in a part number, just move across the device part number, left to right, one character at a time until you find the number.

### Subject Index

This listing is intended to simplify the identification of products where specific device numbers are not known.

	<b>Page</b>
Device Index . . . . .	7.1-1
General Index . . . . .	7.2-1
Subject Index . . . . .	7.2-9

(1) The device numbers contained in this index are for reference only and do not necessarily represent the complete device number necessary to order the device. Contact your local Sales Office or Authorized Distributor for complete ordering information.





# Device Index

Device Index	Page	Device Index	Page	Device Index	Page
AM26LS30	4.6-7	BC807-40LT1	5.1-10	BD244C	5.5-4
BAL99LT1	5.1-36	BC808-25WT1	5.1-11	BD249C	5.5-7
BAS16LT1	5.1-36	BC808-40WT1	5.1-11	BD250C	5.5-7
BAS16WT1	5.1-36	BC817-16LT1	5.1-10	BD437	5.5-9
BAS21LT1	5.1-36	BC817-25LT1	5.1-10	BD438	5.5-9
BAS116LT1	5.1-37	BC817-40LT1	5.1-10	BD440	5.5-9
BAV70LT1	5.1-37	BC818-25WT1	5.1-11	BD441	5.5-9
BAV70WT1	5.1-37	BC818-40WT1	5.1-11	BD442	5.5-9
BAV74LT1	5.1-37	BC818WT1	5.1-11	BD677	5.5-9
BAV99LT1	5.1-37	BC846ALT1	5.1-10	BD677A	5.5-9
BAV99RWT1	5.1-37	BC846AWT1	5.1-11	BD678	5.5-9
BAV99WT1	5.1-37	BC846BLT1	5.1-10	BD678A	5.5-9
BAV170LT1	5.1-38	BC846BWT1	5.1-11	BD679	5.5-9
BAV199LT1	5.1-38	BC847ALT1	5.1-10	BD679A	5.5-9
BAW56LT1	5.1-37	BC847AWT1	5.1-11	BD680	5.5-9
BAW56WT1	5.1-37	BC847BLT1	5.1-10	BD680A	5.5-9
BAW156LT1	5.1-38	BC847BWT1	5.1-11	BD681	5.5-10
BC107	5.1-18	BC847CLT1	5.1-10	BD682	5.5-10
BC107B	5.1-18	BC847CWT1	5.1-11	BD776	5.5-9
BC109C	5.1-18	BC848ALT1	5.1-10	BD777	5.5-9
BC177B	5.1-18	BC848AWT1	5.1-11	BD778	5.5-9
BC182	5.1-2	BC848BLT1	5.1-10	BD779	5.5-10
BC212	5.1-2	BC848BWT1	5.1-11	BD780	5.5-10
BC237B	5.1-2	BC848CLT1	5.1-10	BD787	5.5-9
BC239	5.1-3	BC848CWT1	5.1-11	BD788	5.5-9
BC307B	5.1-2	BC856ALT1	5.1-10	BD789	5.5-9
BC327	5.1-2	BC856AWT1	5.1-11	BD790	5.5-9
BC328	5.1-2	BC856BLT1	5.1-10	BD791	5.5-10
BC337	5.1-2	BC856BWT1	5.1-11	BD792	5.5-10
BC338	5.1-2	BC857ALT1	5.1-10	BD801	5.5-4
BC368	5.1-4	BC857AWT1	5.1-11	BD802	5.5-4
BC369	5.1-4	BC857BLT1	5.1-10	BD808	5.5-5
BC373	5.1-4	BC857BWT1	5.1-11	BD809	5.5-5
BC489	5.1-4	BC858ALT1	5.1-10	BD810	5.5-5
BC490	5.1-4	BC858AWT1	5.1-11	BDB01C	5.1-3
BC517	5.1-4	BC858BLT1	5.1-10	BDB02C	5.1-3
BC546	5.1-2	BC858BWT1	5.1-11	BDB02D	5.1-3
BC546A	5.1-2	BC858CLT1	5.1-10	BDC01D	5.1-3
BC546B	5.1-2	BC858CWT1	5.1-11	BDC02D	5.1-3
BC547	5.1-2	BCP53T1	5.1-16	BDC05	5.1-5
BC547A	5.1-2	BCP56T1	5.1-16	BDV64B	5.5-6
BC547B	5.1-2	BCP68T1	5.1-17	BDV65B	5.5-6
BC547C	5.1-2	BCP69T1	5.1-17	BDW42	5.5-6
BC548	5.1-2	BD135	5.5-9	BDW47	5.5-6
BC548A	5.1-2	BD136	5.5-9	BDX33B	5.5-5
BC548B	5.1-2	BD137	5.5-9	BDX33C	5.5-6
BC548C	5.1-2	BD138	5.5-9	BDX34B	5.5-5
BC549B	5.1-3	BD139	5.5-9	BDX34C	5.5-6
BC549C	5.1-3	BD140	5.5-9	BDX53B	5.5-5
BC550B	5.1-3	BD140-10	5.5-9	BDX53C	5.5-5
BC550C	5.1-3	BD157	5.5-8	BDX54B	5.5-5
BC556	5.1-2	BD158	5.5-8	BDX54C	5.5-5
BC556B	5.1-2	BD159	5.5-9	BF199	5.1-6
BC557	5.1-2	BD165	5.5-9	BF224	5.1-6
BC557A	5.1-2	BD166	5.5-9	BF246A	5.1-21
BC557B	5.1-2	BD169	5.5-9	BF246B	5.1-21
BC557C	5.1-2	BD179	5.5-9	BF393	5.1-5
BC558B	5.1-2	BD180	5.5-9	BF420	5.1-5
BC559B	5.1-3	BD237	5.5-9	BF421	5.1-5
BC559C	5.1-3	BD238	5.5-9	BF422	5.1-5
BC560B	5.1-3	BD241B	5.5-3	BF423	5.1-5
BC560C	5.1-3	BD241C	5.5-3	BF493S	5.1-5
BC618	5.1-4	BD242B	5.5-3	BF720T1	5.1-17
BC639	5.1-4	BD242C	5.5-3	BF721T1	5.1-17
BC640	5.1-4	BD243B	5.5-4	BF844	5.1-5
BC807-16LT1	5.1-10	BD243C	5.5-4	BF959	5.1-6
BC807-25LT1	5.1-10	BD244B	5.5-4	BFR90	5.10-18, 5.10-22

# Device Index

Device Index	Page	Device Index	Page	Device Index	Page
BFR92ALT1	5.10-18	BUY49P	5.5-9	CA2832C	5.10-34
BFR93ALT1	5.10-18	BZX79C2V4RL	5.2-19	CA2833C	5.10-34
BFR96	5.10-18, 5.10-22	BZX79C2V7RL	5.2-19	CA2842C	5.10-34
BFS17LT1	5.10-18	BZX79C3V0RL	5.2-19	CA3059	4.3-2
BS107	5.1-22	BZX79C3V3RL	5.2-19	CATHRU	5.10-37
BS107A	5.1-22	BZX79C3V6RL	5.2-19	CNY17-1	5.8-6
BS170	5.1-22	BZX79C4V3RL	5.2-19	CNY17-2	5.8-6
BSP16T1	5.1-17	BZX79C4V7RL	5.2-19	CNY17-3	5.8-6
BSP19AT1	5.1-17	BZX79C5V1RL	5.2-19	D44C12	5.5-4
BSP20AT1	5.1-17	BZX79C5V6RL	5.2-19	D44H8	5.5-5
BSP52T1	5.1-17	BZX79C6V2RL	5.2-19	D44H10	5.5-5
BSP62T1	5.1-17	BZX79C6V8RL	5.2-19	D44H11	5.5-5
BSS63LT1	5.1-16	BZX79C8V2RL	5.2-19	D44VH10	5.5-6
BSS64LT1	5.1-16	BZX79C9V1RL	5.2-19	D45C12	5.5-4
BSS73	5.1-19	BZX79C12RL	5.2-19	D45H8	5.5-5
BSS76	5.1-19	BZX79C15RL	5.2-19	D45H10	5.5-5
BSS84LT1	5.1-24	BZX79C16RL	5.2-19	D45H11	5.5-5
BSS89	5.1-22	BZX79C33RL	5.2-20	D45VH10	5.5-6
BSS123LT1	5.1-24	BZX84C2V4LT1	5.2-24, 5.2-27	DAN222	5.1-37
BSS138LT1	5.1-24	BZX84C2V7LT1	5.2-24, 5.2-27	DAP222	5.1-37
BSV52LT1	5.1-14	BZX84C3V0LT1	5.2-24, 5.2-27	DS0026	4.2-38
BSX20	5.1-19	BZX84C3V3LT1	5.2-24, 5.2-27	DSP56ADC16	2.1-18
BU208A	5.5-11	BZX84C3V6LT1	5.2-24, 5.2-27	DSP56ADC16S	2.1-18
BU323A	5.5-12	BZX84C3V9LT1	5.2-24, 5.2-27	DSP56KCCA	2.1-20
BU323AP	5.5-6	BZX84C4V3LT1	5.2-24, 5.2-27	DSP56KCCAJ	2.1-20
BU406	5.5-4	BZX84C4V7LT1	5.2-24, 5.2-27	DSP56KCCF	2.1-20
BU407	5.5-4	BZX84C5V1LT1	5.2-24, 5.2-27	DSP56KCCFJ	2.1-20
BU522B	5.5-4	BZX84C5V6LT1	5.2-24, 5.2-27	DSP56KCCJ	2.1-20
BU806	5.5-5	BZX84C6V2LT1	5.2-24, 5.2-27	DSP56L002FC40	2.1-5
BUD43B-1	5.5-17, 5.5-19	BZX84C6V8LT1	5.2-24, 5.2-27	DSP56KCCA	2.1-20
BUD44D2-1	5.5-19	BZX84C7V5LT1	5.2-24, 5.2-27	DSP56KCCF	2.1-20
BUF43B-1	5.5-17	BZX84C8V2LT1	5.2-24, 5.2-27	DSP56KCCJ	2.1-20
BUH50	5.5-17, 5.5-18	BZX84C9V1LT1	5.2-24, 5.2-27	DSP561CCCA	2.1-20
BUH51	5.5-17, 5.5-19	BZX84C10LT1	5.2-24, 5.2-27	DSP561CCCF	2.1-20
BUH100	5.5-17, 5.5-18	BZX84C11LT1	5.2-24, 5.2-27	DSP561CCCH	2.1-20
BUH150	5.5-17, 5.5-18	BZX84C12LT1	5.2-24, 5.2-27	DSP563CCA	2.1-20
BUL43B	5.5-17, 5.5-18	BZX84C13LT1	5.2-24, 5.2-27	DSP563CCF	2.1-20
BUL44	5.5-3, 5.5-17, 5.5-18	BZX84C15LT1	5.2-24, 5.2-27	DSP563CCH	2.1-20
BUL44D2	5.5-17, 5.5-18	BZX84C16LT1	5.2-24, 5.2-27	DSP53000	2.1-20
BUL44D2-1	5.5-17	BZX84C18LT1	5.2-24, 5.2-27	DSP56000	2.1-3, 2.1-4, 2.1-20
BUL44F	5.5-17, 5.5-19	BZX84C20LT1	5.2-24, 5.2-27	DSP56000CLASA	2.1-20
BUL45	5.5-4, 5.5-17, 5.5-18	BZX84C22LT1	5.2-24, 5.2-27	DSP56000CLASB	2.1-20
BUL45D2	5.5-17, 5.5-18	BZX84C24LT1	5.2-24, 5.2-27	DSP56000CLASF	2.1-20
BUL45F	5.5-17, 5.5-19	BZX84C27LT1	5.2-24, 5.2-27	DSP56000CLASH	2.1-20
BUL146	5.5-4, 5.5-17, 5.5-18	BZX84C30LT1	5.2-25, 5.2-27	DSP56002	2.1-3, 2.1-4
BUL146F	5.5-17, 5.5-19	BZX84C33LT1	5.2-25, 5.2-27	DSP56002ADM	2.1-19
BUL147	5.5-5, 5.5-17, 5.5-18	BZX84C36LT1	5.2-25, 5.2-27	DSP56002ADS	2.1-18
BUL147F	5.5-17, 5.5-19	BZX84C39LT1	5.2-25, 5.2-27	DSP56002ADSA	2.1-19
BUS50	5.5-14	BZX84C43LT1	5.2-25, 5.2-27	DSP56002ADSB	2.1-19
BUS98	5.5-14	BZX84C47LT1	5.2-25, 5.2-27	DSP56002ADSF	2.1-19
BUS98A	5.5-14	BZX84C51LT1	5.2-25, 5.2-27	DSP56002ADSH	2.1-19
BUT33	5.5-14	BZX84C56LT1	5.2-25, 5.2-27	DSP56002EVM	2.1-19
BUT34	5.5-14	BZX84C62LT1	5.2-25, 5.2-27	DSP56002FC40	2.1-5
BUV11	5.5-13	BZX84C68LT1	5.2-25, 5.2-27	DSP56002FC66	2.1-5
BUV18A	5.5-14	BZX84C75LT1	5.2-25, 5.2-27	DSP56002RC40	2.1-5
BUV20	5.5-14	C106A	5.7-3	DSP56004	2.1-4
BUV21	5.5-14	C106B	5.7-3	DSP56004ADM	2.1-19
BUV22	5.5-14	C106D	5.7-3	DSP56004ADSA	2.1-19
BUV23	5.5-14	C106F	5.7-3	DSP56004ADSB	2.1-19
BUV48	5.5-7	C106M	5.7-3	DSP56004ADSF	2.1-19
BUV48A	5.5-7, 5.5-17	CA901	5.10-36	DSP56004ADSH	2.1-19
BUV60	5.5-14	CA901A	5.10-36	DSP56005	2.1-5
BUX48	5.5-12	CA922	5.10-37	DSP56005ADPTR	2.1-19
BUX48A	5.5-12	CA922A	5.10-37	DSP56005ADSA	2.1-19
BUX85	5.5-3	CA2810C	5.10-34	DSP56005ADSB	2.1-19
BUX98	5.5-14	CA2818C	5.10-34	DSP56005ADSF	2.1-19
BUX98A	5.5-14	CA2830C	5.10-34	DSP56005ADSH	2.1-19

# Device Index

Device Index	Page	Device Index	Page	Device Index	Page
DSP56007	2.1-4	J110	5.1-21	LM2575TV-15	4.2-14
DSP56007EVM	2.1-19	J111	5.1-21	LM2575TV-Adj	4.2-14
DSP56009	2.1-5	J112	5.1-21	LM2901	4.1-7
DSP56009EVM	2.1-19	J113	5.1-21	LM2901V	4.1-7
DSP56100	2.1-2, 2.1-20	J202	5.1-20	LM2902	4.1-5
DSP56100ADSA	2.1-19	J308	5.1-20	LM2902V	4.1-5
DSP56100ADSB	2.1-19	J309	5.1-20	LM2903	4.1-7
DSP56100ADSF	2.1-19	J310	5.1-20	LM2903V	4.1-7
DSP56100ADSH	2.1-19	LF347	4.1-4	LM2904	4.1-4
DSP56100CLASA	2.1-20	LF347B	4.1-4	LM2904V	4.1-4
DSP56100CLASB	2.1-20	LF351	4.1-2	LM2931	4.2-2, 4.2-3, 4.9-2
DSP56100CLASF	2.1-20	LF353	4.1-3	LM2931A	4.2-3
DSP56100CLASH	2.1-20	LF411C	4.1-2	LM2931A-5.0	4.2-2
DSP56156	2.1-2	LF412C	4.1-3	LM2931C	4.2-4, 4.9-2
DSP56156ADM	2.1-19	LF442C	4.1-3	LM2935	4.2-4, 4.9-2
DSP56156ADS	2.1-18	LF444C	4.1-4	LP1001	5.10-17, 5.10-22
DSP56166ADM	2.1-19	LM201A	4.1-2	LP1001A	5.10-17, 5.10-22
DSP56300	2.1-5, 2.1-6, 2.1-8	LM211	4.1-7	LP2950AC	4.2-2, 4.2-3
DSP56300CLASA	2.1-20	LM224	4.1-4	LP2950C	4.2-2, 4.2-3
DSP56300CLASF	2.1-20	LM224A	4.1-4	LP2951AC	4.2-4
DSP56300CLASH	2.1-20	LM239	4.1-7	LP2951C	4.2-4
DSP56301	2.1-6, 2.1-7	LM239A	4.1-7	M1MA141KT1	5.1-36
DSP56301ADSA	2.1-19	LM258	4.1-3	M1MA141WAT1	5.1-37
DSP56301ADSF	2.1-19	LM285Z-1.2	4.4-2	M1MA141WKT1	5.1-37
DSP56301ADSH	2.1-19	LM285Z-2.5	4.4-2	M1MA142KT1	5.1-36
DSP56302	2.1-8, 2.1-10	LM301A	4.1-2	M1MA142WAT1	5.1-37
DSP56303	2.1-10, 2.1-12	LM308A	4.1-2	M1MA142WKT1	5.1-37
DSP56600	2.1-12	LM311	4.1-7	M1MA151AT1	5.1-36
DSP56602	2.1-12, 2.1-14	LM317	4.2-5	M1MA151KT1	5.1-36
DSP56603	2.1-14, 2.1-16	LM317B	4.2-4, 4.2-5	M1MA151WAT1	5.1-37
DSP56800	2.1-3	LM317L	4.2-4	M1MA151WKT1	5.1-37
DSP96000	2.1-20	LM317M	4.2-5	M1MA174T1	5.1-36
DSP96000ADM	2.1-19	LM323	4.2-3	M68HC05BPGMR	2.6-23
DSP96000ADS	2.1-18	LM323A	4.2-3	M68HC05C5EVS	2.6-23
DSP96000ADSA	2.1-19	LM324	4.1-4	M68HC05C9EVS	2.6-23
DSP96000ADSB	2.1-19	LM324A	4.1-4	M68HC05D32EVS	2.6-23
DSP96000ADSF	2.1-19	LM337	4.2-5	M68HC05E1EVS	2.6-23
DSP96000ADSH	2.1-19	LM337B	4.2-5	M68HC05F6EVM	2.6-23
DSP96000CLASA	2.1-20	LM337M	4.2-5	M68HC05F8EVM	2.6-23
DSP96000CLASB	2.1-20	LM339	4.1-7	M68HC05G1EVM	2.6-23
DSP96000CLASF	2.1-20	LM339A	4.1-7	M68HC05G9EVM	2.6-23
DSP96000CLASH	2.1-20	LM340	4.2-3	M68HC05G10EVM	2.6-23
DSP96002	2.1-17	LM340-24	4.2-3	M68HC05H2EVS	2.6-23
DSPCOMMAND	2.1-19	LM340A-XX	4.2-3	M68HC05I8EVS	2.6-23
DSPMACHOST	2.1-19	LM350	4.2-5	M68HC05J3EVS	2.6-23
DSPPCHOST	2.1-19	LM350B	4.2-5	M68HC05L1EVM	2.6-24
DSPSUN4HOST	2.1-19	LM358	4.1-3	M68HC05L2EVS	2.6-24
DTA114YE	5.1-13	LM385BZ-1.2	4.4-2	M68HC05L4EVS	2.6-24
DTA143EE	5.1-13	LM385BZ-2.5	4.4-2	M68HC05L5EVS	2.6-24
DTC114TE	5.1-13	LM385Z-1.2	4.4-2	M68HC05L9EVM2	2.6-24
DTC114YE	5.1-13	LM385Z-2.5	4.4-2	M68HC05L10EVM	2.6-24
H11A1	5.8-6	LM393	4.1-7	M68HC05L11EVM	2.6-24
H11A550	5.8-6	LM393A	4.1-7	M68HC05M4EVM	2.6-24
H11AA1	5.8-6	LM833	4.1-3	M68HC05P3EVS	2.6-24
H11AA2	5.8-6	LM2575D2T-3.3	4.2-14	M68HC05P8EVS	2.6-23, 2.6-24
H11AA3	5.8-6	LM2575D2T-5	4.2-14	M68HC05P9EVS	2.6-24
H11AA4	5.8-6	LM2575D2T-12	4.2-14	M68HC05PGMR-2	2.6-23
H11AV1	5.8-6	LM2575D2T-15	4.2-14	M68HC05SCEVS	2.6-24
H11AV2	5.8-6	LM2575D2T-Adj	4.2-14	M68HC05T2EVS	2.6-24
H11B1	5.8-7	LM2575T-3.3	4.2-14	M68HC05T4EVM	2.6-24
H11D1	5.8-7	LM2575T-5	4.2-14	M68HC05T7EVM	2.6-24
H11D2	5.8-7	LM2575T-12	4.2-14	M68HC05T12EVM	2.6-24
H11G1	5.8-7	LM2575T-15	4.2-14	M68HC05X4EVS	2.6-24
H11G2	5.8-7	LM2575T-Adj	4.2-14	M68HC05X16EVS	2.6-23, 2.6-24
H11G3	5.8-7	LM2575TV-3.3	4.2-14	M68HC11EVBU	2.6-24
H11L1	5.8-8	LM2575TV-5	4.2-14	M68HC11EVBU	2.6-24
H11L2	5.8-8	LM2575TV-12	4.2-14		

# Device Index

Device Index	Page	Device Index	Page	Device Index	Page
M68HC11EVM	2.6-24	MAC15A6	5.7-12	MAC320A4	5.7-13
M68HC705F8PGMR	2.6-23	MAC15A6FP	5.7-12	MAC320A4FP	5.7-13
M68HC705G1PGMR	2.6-23	MAC15A8	5.7-12	MAC320A6	5.7-13
M68HC705G9PGMR	2.6-23	MAC15A8FP	5.7-12	MAC320A6FP	5.7-13
M68HC705J2PGMR	2.6-23	MAC15A10	5.7-12	MAC320A8	5.7-13
M68HC705K1CS	2.6-23	MAC15A10FP	5.7-12	MAC320A8FP	5.7-13
M68HC705K1GANG	2.6-23	MAC15D	5.7-12	MAC320A10	5.7-13
M68HC705L2PGMR	2.6-24	MAC15M	5.7-12	MAC320A10FP	5.7-13
M68HC705L4PGMR	2.6-23, 2.6-24	MAC15N	5.7-12	MAC321-4	5.7-13
M68HC705L5PGMR	2.6-24	MAC15SD	5.7-12	MAC321-6	5.7-13
M68HC705P9PGMR	2.6-24	MAC15SM	5.7-12	MAC321-8	5.7-13
M68HC705T10PGMR	2.6-24	MAC15SN	5.7-12	MAC321-10	5.7-13
M68HC705T12PGMR	2.6-24	MAC16D	5.7-12	MAD130P	5.1-40
M68HC705X4PGMR	2.6-24	MAC16M	5.7-12	MAD1103P	5.1-40
M68HC705X16PGMR	2.6-24	MAC16N	5.7-12	MAD1107P	5.1-40
M68HC711D3EVB	2.6-24	MAC97-6	5.7-7	MAD1108P	5.1-40
M68MEVB16Z1	2.6-25	MAC97-8	5.7-7	MAD1109P	5.1-40
M68MEVB333	2.6-25	MAC97A6	5.7-7	MB321BJ08T	2.8-9
M68701EVM	2.6-23	MAC97A8	5.7-7	MB321BT08T	2.8-9
M143120B1EVBU	2.7-8	MAC210A4	5.7-11	MB321BT18T	2.8-9
M143120EVK	2.7-8	MAC210A4FP	5.7-11	MB322BJ08T	2.8-9
M143150B1EVBU	2.7-8	MAC210A6	5.7-11	MB322BT08T	2.8-9
M143150EVK	2.7-8	MAC210A6FP	5.7-11	MB322BT18T	2.8-9
M143204EVK	2.7-8	MAC210A8	5.7-11	MB324CJ00T	2.8-9
M143206EVK	2.7-8	MAC210A8FP	5.7-11	MB324CT00T	2.8-9
M143207EVK	2.7-8	MAC210A10	5.7-11	MB324CT10T	2.8-9
M143208EVK	2.7-8	MAC210A10FP	5.7-11	MB328CJ00T	2.8-9
M143213EVK5	2.7-8	MAC212A4	5.7-11	MB328CT00T	2.8-9
M143213EVK6	2.7-8	MAC212A4FP	5.7-11	MB641BT08T	2.8-10
M143214EVK5	2.7-8	MAC212A6	5.7-11	MB641BT18T	2.8-10
M143214EVK6	2.7-8	MAC212A6FP	5.7-11	MB641BT48T	2.8-10
M143215EVK5	2.7-8	MAC212A8	5.7-11	MB642BT08T	2.8-10
M143215EVK6	2.7-8	MAC212A8FP	5.7-11	MB642BT18T	2.8-10
M143221EVK	2.7-8	MAC212A10	5.7-11	MB642BT48T	2.8-10
M143222EVK	2.7-8	MAC212A10FP	5.7-11	MB644CT00T	2.8-10
M143223EVK	2.7-8	MAC218A4	5.7-9	MB644CT10T	2.8-10
M143226EVK	2.7-8	MAC218A4FP	5.7-9	MB724CJ40T	2.8-10
M143232EVK	2.7-8	MAC218A6	5.7-9	MB724CT00T	2.8-10
MA321BT08T	2.8-9	MAC218A6FP	5.7-9	MB724CT10T	2.8-10
MA322BT08T	2.8-9	MAC218A8	5.7-9	MBD101	5.1-33, 5.1-34
MA641AJ40T	2.8-10	MAC218A8FP	5.7-9	MBD110DWT1	5.1-34
MA641BT08T	2.8-10	MAC218A10	5.7-9	MBD301	5.1-33, 5.1-34
MA642BT08T	2.8-10	MAC218A10FP	5.7-9	MBD330DWT1	5.1-34
MA644CT00T	2.8-10	MAC223A4	5.7-13	MBD701	5.1-33, 5.1-34
MA644CT10T	2.8-10	MAC223A4FP	5.7-13	MBD770DWT1	5.1-34
MA721BT08T	2.8-10	MAC223A6	5.7-13	MBF4416DW1T1	5.1-23
MA722BT08T	2.8-10	MAC223A6FP	5.7-13	MBF5457DW1T1	5.1-23
MA724CJ40T	2.8-10	MAC223A8	5.7-13	MBR160	5.6-6
MA724CT00T	2.8-10	MAC223A8FP	5.7-13	MBR340	5.6-6
MA724CT10T	2.8-10	MAC223A10	5.7-13	MBR360	5.6-6
MAC08BT1	5.7-7	MAC223A10FP	5.7-13	MBR0520LT1	5.6-3, 5.6-4
MAC8D	5.7-9	MAC224A4	5.7-13	MBR0530T1	5.6-4
MAC08DT1	5.7-7	MAC224A6	5.7-13	MBR0540T1	5.6-4
MAC8M	5.7-9	MAC224A8	5.7-13	MBR745	5.6-7
MAC08MT1	5.7-7	MAC224A10	5.7-13	MBR1045	5.6-7
MAC8N	5.7-9	MAC228A4	5.7-10	MBR1060	5.6-7
MAC8SD	5.7-9	MAC228A4FP	5.7-10	MBR1100	5.6-6
MAC8SM	5.7-9	MAC228A6	5.7-10	MBR1545CT	5.6-7
MAC8SN	5.7-9	MAC228A6FP	5.7-10	MBR1645	5.6-7
MAC9D	5.7-9	MAC228A8	5.7-10	MBR2030CTL	5.6-3, 5.6-7
MAC9M	5.7-9	MAC228A8FP	5.7-10	MBR2045CT	5.6-7
MAC9N	5.7-9	MAC228A10	5.7-10	MBR2060CT	5.6-7
MAC12D	5.7-12	MAC228A10FP	5.7-10	MBR2515L	5.6-3, 5.6-7
MAC12M	5.7-12	MAC310A4	5.7-11	MBR2535CTL	5.6-3, 5.6-7
MAC12N	5.7-12	MAC310A6	5.7-11	MBR2545CT	5.6-7
MAC15A4	5.7-12	MAC310A8	5.7-11	MBR3045PT	5.6-8
MAC15A4FP	5.7-12	MAC310A10	5.7-11	MBR3045ST	5.6-7

# Device Index

Device Index	Page	Device Index	Page	Device Index	Page
MBR3045WT	5.6-8	MC10E136	3.1-18	MC10H102	3.1-28
MBR3100	5.6-6	MC10E137	3.1-19	MC10H103	3.1-28
MBR4015LWT	5.6-3, 5.6-8	MC10E141	3.1-37	MC10H104	3.1-25
MBR4045PT	5.6-8	MC10E142	3.1-37	MC10H105	3.1-27
MBR4045WT	5.6-8	MC10E143	3.1-22	MC10H106	3.1-28
MBR5025L	5.6-3, 5.6-8	MC10E150	3.1-30	MC10H107	3.1-27
MBR6045PT	5.6-8	MC10E151	3.1-22	MC10H109	3.1-27
MBR6045WT	5.6-8	MC10E154	3.1-30	MC10H113	3.1-27
MBR7030WT	5.6-8	MC10E155	3.1-30	MC10H115	3.1-35
MBR10100	5.6-7	MC10E156	3.1-30	MC10H116	3.1-36
MBR20100CT	5.6-7	MC10E157	3.1-33	MC10H117	3.1-27
MBR20200CT	5.6-7	MC10E158	3.1-31	MC10H118	3.1-27
MBRA130LT3	5.6-4	MC10E160	3.1-34	MC10H119	3.1-26
MBRA140T3	5.6-4	MC10E163	3.1-31	MC10H121	3.1-26
MBRB1545CT	5.6-5	MC10E164	3.1-31	MC10H123	3.1-16
MBRB2060CT	5.6-5	MC10E166	3.1-18	MC10H124	3.1-39
MBRB2515L	5.6-3, 5.6-5	MC10E167	3.1-22	MC10H125	3.1-39
MBRB2535CTL	5.6-3, 5.6-5	MC10E171	3.1-31	MC10H130	3.1-30
MBRB2545CT	5.6-5	MC10E175	3.1-30	MC10H131	3.1-23
MBRB3030CT	5.6-5	MC10E193	3.1-34	MC10H135	3.1-23
MBRB3030CTL	5.6-3, 5.6-5	MC10E195	3.1-35	MC10H136	3.1-20
MBRB4030	5.6-5	MC10E196	3.1-35	MC10H141	3.1-37
MBRB20100CT	5.6-5	MC10E197	3.1-31	MC10H145	3.1-36
MBRB20200CT	5.6-5	MC10E211	3.1-16	MC10H158	3.1-33
MBRD340	5.6-5	MC10E212	3.1-36	MC10H159	3.1-33
MBRD360	5.6-5	MC10E241	3.1-37	MC10H160	3.1-34
MBRD640CT	5.6-5	MC10E256	3.1-30	MC10H161	3.1-20
MBRD660CT	5.6-5	MC10E336	3.1-14	MC10H162	3.1-20
MBRD835L	5.6-3, 5.6-5	MC10E337	3.1-14	MC10H164	3.1-31
MBRD1035CTL	5.6-3, 5.6-5	MC10E404	3.1-27	MC10H165	3.1-22
MBRF745	5.6-7	MC10E411	3.1-16	MC10H166	3.1-18
MBRF1045	5.6-7	MC10E416	3.1-35	MC10H171	3.1-21
MBRF1545CT	5.6-7	MC10E431	3.1-22	MC10H172	3.1-21
MBRF2045CT	5.6-7	MC10E445	3.1-18	MC10H173	3.1-32
MBRF2060CT	5.6-7	MC10E446	3.1-18	MC10H174	3.1-32
MBRF2545CT	5.6-7	MC10E451	3.1-22	MC10H175	3.1-31
MBRF20100CT	5.6-7	MC10E452	3.1-22	MC10H176	3.1-23
MBRF20200CT	5.6-7	MC10E457	3.1-33	MC10H179	3.1-13
MBRP20030CTL	5.6-3, 5.6-9	MC10E1651	3.1-18	MC10H180	3.1-13
MBRP20045CT	5.6-9	MC10E1652	3.1-18	MC10H181	3.1-13
MBRP20060CT	5.6-9	MC10EL01	3.1-26	MC10H186	3.1-23
MBRP30045CT	5.6-9	MC10EL04	3.1-26	MC10H188	3.1-29
MBRP30060CT	5.6-9	MC10EL05	3.1-26	MC10H189	3.1-29
MBRP60035CTL	5.6-3, 5.6-9	MC10EL07	3.1-26	MC10H209	3.1-27
MBRS130LT3	5.6-3, 5.6-4	MC10EL11	3.1-16	MC10H210	3.1-28
MBRS140T3	5.6-4	MC10EL12	3.1-29	MC10H211	3.1-28
MBRS340T3	5.6-4	MC10EL15	3.1-16	MC10H330	3.1-16
MBRS360T3	5.6-4	MC10EL16	3.1-35	MC10H332	3.1-14
MBRS1100T3	5.6-4	MC10EL31	3.1-22	MC10H334	3.1-16
MBRV7030CTL	5.6-5	MC10EL32	3.1-21	MC10H350	3.1-38
MBS4991	5.7-14	MC10EL33	3.1-21	MC10H351	3.1-39
MBS4992	5.7-14	MC10EL34	3.1-17	MC10H352	3.1-38
MBS4993	5.7-14	MC10EL35	3.1-23	MC10H423	3.1-16
MBT3904DW1T1	5.1-11	MC10EL51	3.1-22	MC10H424	3.1-39
MBT3904DW9T1	5.1-11	MC10EL52	3.1-22	MC10H600	3.1-38
MBT3906DW1T1	5.1-11, 5.1-12	MC10EL57	3.1-31	MC10H601	3.1-38
MBT3906DW9T1	5.1-11	MC10EL58	3.1-31	MC10H602	3.1-38
MBV109T1	5.1-31	MC10EL89	3.1-21	MC10H603	3.1-38
MC10E016	3.1-19	MC10ELT20	3.1-39	MC10H604	3.1-39
MC10E101	3.1-27	MC10ELT21	3.1-38	MC10H605	3.1-39
MC10E104	3.1-27	MC10ELT22	3.1-38	MC10H606	3.1-39
MC10E107	3.1-27	MC10ELT24	3.1-39	MC10H607	3.1-39
MC10E111	3.1-16	MC10ELT25	3.1-38	MC10H640	3.1-17
MC10E112	3.1-29	MC10ELT28	3.1-39	MC10H641	3.1-17
MC10E116	3.1-35	MC10H16	3.1-18	MC10H642	3.1-17
MC10E122	3.1-29	MC10H100	3.1-28	MC10H643	3.1-17
MC10E131	3.1-22	MC10H101	3.1-27	MC10H644	3.1-17

# Device Index

<u>Device Index</u>	<u>Page</u>	<u>Device Index</u>	<u>Page</u>	<u>Device Index</u>	<u>Page</u>
MC10H645	3.1-16	MC54HC393	3.1-19	MC68HC05CJ4	2.5-6
MC10H646	3.1-17	MC54HC533A	3.1-31	MC68HC05D9	2.5-6, 2.6-23
MC10H660	3.1-31	MC54HC534A	3.1-24	MC68HC05D24	2.5-6, 2.6-23
MC10H680	3.1-38	MC54HC540A	3.1-15	MC68HC05E1	2.5-6, 2.6-23
MC10H681	3.1-38	MC54HC541A	3.1-15	MC68HC05E6	2.5-6
MC10SX1125	3.1-13	MC54HC563A	3.1-31	MC68HC05E16	2.5-6
MC10SX1130	3.1-17, 3.1-21	MC54HC573A	3.1-31	MC68HC05F5	2.5-6
MC10SX1189	3.1-17	MC54HC574A	3.1-24	MC68HC05F6	2.5-6
MC14C88B	4.6-7	MC54HC589	3.1-37	MC68HC05F8	2.5-7
MC14C89AB	4.6-7	MC54HC589A	3.1-37	MC68HC05G1	2.5-7, 2.6-23
MC14C89B	4.6-7	MC54HC595A	3.1-37	MC68HC05G3	2.5-7
MC14LC5447	4.7-33	MC54HC597	3.1-37	MC68HC05J1	2.6-23
MC14LC5447DW	4.7-33	MC54HC597A	3.1-37	MC68HC05J1A	2.5-7
MC14LC5447P	4.7-33	MC54HC640A	3.1-15	MC68HC05J3	2.5-7
MC14LC5472	4.7-15	MC54HC646	3.1-16	MC68HC05K0	2.5-7
MC14LC5480	4.7-12, 4.7-15, 4.7-32	MC54HC688	3.1-18	MC68HC05K1	2.5-7
MC14LC5480DW	4.7-12	MC54HC4016	3.1-33	MC68HC05K3	2.5-7
MC14LC5480P	4.7-12	MC54HC4040A	3.1-18	MC68HC05L1	2.5-7
MC14LC5480SD	4.7-12	MC54HC4049	3.1-29	MC68HC05L5	2.5-7, 2.6-24
MC14LC5494EVK	4.7-17	MC54HC4050	3.1-29	MC68HC05L7	2.6-24
MC14LC5540	4.7-13, 4.7-14, 4.7-15	MC54HC4051	3.1-31	MC68HC05L9	2.6-24
MC14LC5540DW	4.7-13	MC54HC4053	3.1-33	MC68HC05L10	2.6-24
MC14LC5540FU	4.7-13	MC54HC4060	3.1-18	MC68HC05L16	2.5-7
MC14LC5540P	4.7-13	MC54HC4060A	3.1-18	MC68HC05P1	2.6-24
MC26LS30	4.6-7	MC54HC4066	3.1-33	MC68HC05P1A	2.5-7
MC44xxx Family	4.8-7, 4.8-10	MC54HC4351	3.1-31	MC68HC05P3	2.5-7
MC54HC00A	3.1-26	MC54HC4353	3.1-33	MC68HC05P4	2.5-7, 2.6-24
MC54HC02A	3.1-28	MC54HC4538A	3.1-33	MC68HC05P6	2.5-7, 2.6-24
MC54HC04A	3.1-29	MC54HCT00A	3.1-26	MC68HC05P7	2.5-7, 2.6-24
MC54HC08A	3.1-25	MC54HCT08A	3.1-25	MC68HC05P8	2.5-7, 2.6-24
MC54HC14A	3.1-36	MC54HCT14A	3.1-36	MC68HC05P9	2.5-7, 2.6-24
MC54HC27	3.1-28	MC54HCT32A	3.1-28	MC68HC05PE0	2.5-8
MC54HC32A	3.1-28	MC54HCT161A	3.1-19	MC68HC05SC11	2.5-8
MC54HC74A	3.1-23	MC54HCT163A	3.1-19	MC68HC05SC21	2.5-8
MC54HC86	3.1-27	MC54HCT241A	3.1-15	MC68HC05SC24	2.5-8
MC54HC86A	3.1-27	MC54HCT244A	3.1-15	MC68HC05SC26	2.5-8
MC54HC132A	3.1-36	MC54HCT245A	3.1-14	MC68HC05SC27	2.5-8
MC54HC138A	3.1-20	MC54HCT373A	3.1-30	MC68HC05T1	2.5-8, 2.6-24
MC54HC139A	3.1-21	MC54HCT374A	3.1-24	MC68HC05T7	2.6-24
MC54HC154	3.1-20	MC54HCT574A	3.1-24	MC68HC05T10	2.5-8, 2.6-24
MC54HC157A	3.1-32	MC68B00	2.6-10	MC68HC05T16	2.5-8
MC54HC158	3.1-32	MC68B09	2.6-10	MC68HC05X1	2.5-8
MC54HC160	3.1-19	MC68B09E	2.6-10	MC68HC05X4	2.5-8
MC54HC161A	3.1-19	MC68B10	2.6-10	MC68HC05X16	2.5-8
MC54HC162	3.1-19	MC68B21	2.6-10	MC68HC05X32	2.5-8
MC54HC163A	3.1-19	MC68B40	2.6-10	MC68HC11A0	2.6-6, 2.6-24
MC54HC164	3.1-37	MC68B44	2.6-10	MC68HC11A1	2.6-6, 2.6-24
MC54HC164A	3.1-37	MC68B50	2.6-10	MC68HC11A7	2.6-6
MC54HC165	3.1-37	MC68B52	2.6-10	MC68HC11A8	2.6-6, 2.6-24
MC54HC174A	3.1-23	MC68B54	2.6-10	MC68HC11D0	2.6-6, 2.6-24
MC54HC175	3.1-25	MC68B488	2.6-10	MC68HC11D3	2.6-6, 2.6-24
MC54HC175A	3.1-25	MC68F333	2.6-25	MC68HC11E0	2.6-6, 2.6-24
MC54HC240A	3.1-15	MC68HC05	4.7-16	MC68HC11E1	2.6-6, 2.6-24
MC54HC241A	3.1-15	MC68HC05B4	2.5-6, 2.6-23	MC68HC11E2	2.6-24
MC54HC244A	3.1-16	MC68HC05B6	2.5-6, 2.6-23	MC68HC11E8	2.6-6
MC54HC245A	3.1-16	MC68HC05B8	2.5-6, 2.6-23	MC68HC11E9	2.6-6, 2.6-24
MC54HC251	3.1-31	MC68HC05B13	2.5-6, 2.6-23	MC68HC11ED0	2.6-6
MC54HC259	3.1-20	MC68HC05BD3	2.5-6	MC68HC11F1	2.6-6, 2.6-25
MC54HC273A	3.1-24	MC68HC05BD5	2.5-6	MC68HC11G5	2.6-25
MC54HC354	3.1-31	MC68HC05C4	2.6-23	MC68HC11G7	2.6-25
MC54HC365	3.1-14	MC68HC05C4A	2.5-6, 2.6-23	MC68HC11K0	2.6-7, 2.6-25
MC54HC366	3.1-14	MC68HC05C5	2.5-6, 2.6-23	MC68HC11K1	2.6-7, 2.6-25
MC54HC367	3.1-14	MC68HC05C8	2.6-23	MC68HC11K3	2.6-7
MC54HC373A	3.1-31	MC68HC05C8A	2.5-6	MC68HC11K4	2.6-7, 2.6-25
MC54HC374A	3.1-24	MC68HC05C9	2.6-23	MC68HC11KA0	2.6-7
MC54HC390	3.1-19	MC68HC05C9A	2.5-6	MC68HC11KA1	2.6-7
		MC68HC05C12	2.5-6, 2.6-23	MC68HC11KA3	2.6-7

# Device Index

<u>Device Index</u>	<u>Page</u>	<u>Device Index</u>	<u>Page</u>	<u>Device Index</u>	<u>Page</u>
MC68HC11KA4	2.6-7, 2.6-25	MC74AC138	3.1-20	MC74ACT125	3.1-16
MC68HC11L0	2.6-7, 2.6-25	MC74AC139	3.1-21	MC74ACT126	3.1-16
MC68HC11L1	2.6-7, 2.6-25	MC74AC151	3.1-31	MC74ACT132	3.1-36
MC68HC11L5	2.6-7	MC74AC153	3.1-32	MC74ACT138	3.1-20
MC68HC11L6	2.6-8, 2.6-25	MC74AC157	3.1-33	MC74ACT139	3.1-21
MC68HC11M2	2.6-8, 2.6-25	MC74AC158	3.1-33	MC74ACT151	3.1-31
MC68HC11N4	2.6-25	MC74AC160	3.1-20	MC74ACT153	3.1-32
MC68HC11P2	2.6-25	MC74AC161	3.1-20	MC74ACT157	3.1-33
MC68HC16Y1	2.6-18, 2.6-25	MC74AC162	3.1-20	MC74ACT158	3.1-33
MC68HC16Z1	2.6-18, 2.6-25	MC74AC163	3.1-20	MC74ACT160	3.1-20
MC68HC16Z2	2.6-18, 2.6-25	MC74AC174	3.1-23	MC74ACT161	3.1-20
MC68HC24	2.6-10	MC74AC175	3.1-24	MC74ACT162	3.1-20
MC68HC27	2.6-10	MC74AC190	3.1-20	MC74ACT163	3.1-20
MC68HC68L9	2.6-11	MC74AC194	3.1-37	MC74ACT174	3.1-23
MC68HC705B5	2.5-9, 2.6-23	MC74AC240	3.1-15	MC74ACT175	3.1-24
MC68HC705B16	2.5-9, 2.6-23	MC74AC241	3.1-15	MC74ACT194	3.1-37
MC68HC705BD3	2.5-9	MC74AC244	3.1-15	MC74ACT240	3.1-15
MC68HC705C4A	2.5-9	MC74AC245	3.1-14	MC74ACT241	3.1-15
MC68HC705C8	2.6-23	MC74AC251	3.1-31	MC74ACT244	3.1-15
MC68HC705C8A	2.5-9	MC74AC253	3.1-32	MC74ACT245	3.1-14
MC68HC705C9A	2.5-9	MC74AC256	3.1-30	MC74ACT251	3.1-31
MC68HC705CJ4	2.5-9	MC74AC257	3.1-32	MC74ACT253	3.1-32
MC68HC705D9	2.6-23	MC74AC258	3.1-32	MC74ACT256	3.1-30
MC68HC705E1	2.5-9, 2.6-23	MC74AC259	3.1-30	MC74ACT257	3.1-32
MC68HC705F8	2.5-9	MC74AC273	3.1-24	MC74ACT258	3.1-32
MC68HC705G1	2.5-9, 2.6-23	MC74AC299	3.1-37	MC74ACT259	3.1-30
MC68HC705G4	2.5-9	MC74AC323	3.1-37	MC74ACT273	3.1-24
MC68HC705J1A	2.5-9	MC74AC350	3.1-37	MC74ACT299	3.1-37
MC68HC705J2	2.5-9, 2.6-23	MC74AC352	3.1-32	MC74ACT323	3.1-37
MC68HC705K1	2.5-9	MC74AC353	3.1-32	MC74ACT350	3.1-37
MC68HC705L5	2.5-10, 2.6-24	MC74AC373	3.1-30	MC74ACT352	3.1-32
MC68HC705L16	2.5-10	MC74AC374	3.1-24	MC74ACT353	3.1-32
MC68HC705P6	2.5-10	MC74AC377	3.1-24	MC74ACT373	3.1-30
MC68HC705P9	2.5-10	MC74AC378	3.1-22	MC74ACT374	3.1-24
MC68HC705SR3	2.5-10	MC74AC533	3.1-30	MC74ACT377	3.1-24
MC68HC705T10	2.5-10	MC74AC534	3.1-24	MC74ACT378	3.1-22
MC68HC705T16	2.5-10	MC74AC540	3.1-15	MC74ACT521	3.1-18
MC68HC705X16	2.6-24	MC74AC541	3.1-15	MC74ACT533	3.1-30
MC68HC711D3	2.6-24	MC74AC563	3.1-30	MC74ACT534	3.1-24
MC68HC711E9	2.6-24	MC74AC564	3.1-24	MC74ACT540	3.1-15
MC68HC711G5	2.6-25	MC74AC573	3.1-30	MC74ACT541	3.1-15
MC68HC711K4	2.6-25	MC74AC574	3.1-24	MC74ACT563	3.1-30
MC68HC711L6	2.6-25	MC74AC620	3.1-14	MC74ACT564	3.1-24
MC68HC711M2	2.6-25	MC74AC623	3.1-14	MC74ACT573	3.1-30
MC68HC711N4	2.6-25	MC74AC640	3.1-14	MC74ACT574	3.1-24
MC68HC711P2	2.6-25	MC74AC643	3.1-14	MC74ACT620	3.1-14
MC68HC811A8	2.6-24	MC74AC646	3.1-15	MC74ACT623	3.1-14
MC68HC811E2	2.6-6, 2.6-24	MC74AC648	3.1-15	MC74ACT640	3.1-14
MC68HCBC34	2.6-10	MC74AC652	3.1-15	MC74ACT643	3.1-14
MC74AC00	3.1-26	MC74AC810	3.1-27	MC74ACT646	3.1-15
MC74AC02	3.1-28	MC74AC4020	3.1-18	MC74ACT648	3.1-15
MC74AC04	3.1-29	MC74AC4040	3.1-18	MC74ACT652	3.1-15
MC74AC05	3.1-29	MC74ACT00	3.1-26	MC74ACT810	3.1-27
MC74AC08	3.1-25	MC74ACT02	3.1-28	MC74F00	3.1-26
MC74AC10	3.1-26	MC74ACT04	3.1-29	MC74F02	3.1-28
MC74AC11	3.1-26	MC74ACT05	3.1-29	MC74F04	3.1-29
MC74AC14	3.1-36	MC74ACT08	3.1-25	MC74F08	3.1-25
MC74AC20	3.1-25	MC74ACT10	3.1-26	MC74F10	3.1-26
MC74AC32	3.1-28	MC74ACT11	3.1-26	MC74F11	3.1-26
MC74AC74	3.1-22	MC74ACT14	3.1-36	MC74F13	3.1-36
MC74AC86	3.1-27	MC74ACT20	3.1-25	MC74F14	3.1-36
MC74AC109	3.1-23	MC74ACT32	3.1-28	MC74F20	3.1-25
MC74AC112	3.1-23	MC74ACT74	3.1-22	MC74F21	3.1-25
MC74AC113	3.1-23	MC74ACT86	3.1-27	MC74F32	3.1-28
MC74AC125	3.1-16	MC74ACT109	3.1-23	MC74F37	3.1-25
MC74AC126	3.1-16	MC74ACT112	3.1-23	MC74F38	3.1-26
MC74AC132	3.1-36	MC74ACT113	3.1-23	MC74F40	3.1-25

# Device Index

<u>Device Index</u>	<u>Page</u>	<u>Device Index</u>	<u>Page</u>	<u>Device Index</u>	<u>Page</u>
MC74F51	3.1-27	MC74F538	3.1-20	MC74HC164A	3.1-37
MC74F64	3.1-26	MC74F539	3.1-20	MC74HC165	3.1-37
MC74F74	3.1-23	MC74F543	3.1-15	MC74HC173	3.1-25
MC74F85	3.1-17	MC74F544	3.1-15	MC74HC174A	3.1-23
MC74F86	3.1-27	MC74F568	3.1-18	MC74HC175	3.1-25
MC74F109	3.1-23	MC74F569	3.1-18	MC74HC175A	3.1-25
MC74F112	3.1-23	MC74F574	3.1-24	MC74HC194	3.1-37
MC74F125	3.1-16	MC74F579	3.1-19	MC74HC195	3.1-37
MC74F126	3.1-16	MC74F620	3.1-15	MC74HC237	3.1-20
MC74F132	3.1-36	MC74F623	3.1-15	MC74HC240A	3.1-15
MC74F138	3.1-20	MC74F640	3.1-15	MC74HC241A	3.1-15
MC74F139	3.1-21	MC74F646	3.1-15	MC74HC242	3.1-16
MC74F148	3.1-22	MC74F657A	3.1-14	MC74HC244A	3.1-16
MC74F151	3.1-31	MC74F657B	3.1-14	MC74HC245A	3.1-16
MC74F153	3.1-32	MC74F779	3.1-19	MC74HC251	3.1-31
MC74F157A	3.1-32	MC74F803	3.1-17	MC74HC253	3.1-32
MC74F158A	3.1-32	MC74F823	3.1-14	MC74HC257	3.1-32
MC74F160A	3.1-19	MC74F827	3.1-14	MC74HC259	3.1-20
MC74F161A	3.1-19	MC74F828	3.1-14	MC74HC273A	3.1-24
MC74F162A	3.1-19	MC74F1245	3.1-14	MC74HC280	3.1-34
MC74F163A	3.1-19	MC74F1803	3.1-17	MC74HC299	3.1-37
MC74F164	3.1-37	MC74F2245	3.1-38	MC74HC354	3.1-31
MC74F168	3.1-18	MC74F3893A	3.1-38	MC74HC365	3.1-14
MC74F169	3.1-18	MC74HC00A	3.1-26	MC74HC366	3.1-14
MC74F174	3.1-23	MC74HC02A	3.1-28	MC74HC367	3.1-14
MC74F175	3.1-24	MC74HC03A	3.1-26	MC74HC368	3.1-14
MC74F181	3.1-13	MC74HC04A	3.1-29	MC74HC373A	3.1-31
MC74F182	3.1-13	MC74HC08A	3.1-25	MC74HC374A	3.1-24
MC74F194	3.1-37	MC74HC10	3.1-26	MC74HC390	3.1-19
MC74F195	3.1-37	MC74HC11	3.1-26	MC74HC393	3.1-19
MC74F240	3.1-15	MC74HC14A	3.1-36	MC74HC533A	3.1-31
MC74F241	3.1-15	MC74HC20	3.1-25	MC74HC534A	3.1-24
MC74F242	3.1-16	MC74HC27	3.1-28	MC74HC540A	3.1-15
MC74F243	3.1-16	MC74HC30	3.1-25	MC74HC541A	3.1-15
MC74F244	3.1-15	MC74HC32A	3.1-28	MC74HC563A	3.1-31
MC74F245	3.1-14	MC74HC42	3.1-20	MC74HC564A	3.1-24
MC74F251	3.1-31	MC74HC51	3.1-26	MC74HC573A	3.1-31
MC74F253	3.1-32	MC74HC58	3.1-26	MC74HC574A	3.1-24
MC74F256	3.1-30	MC74HC73	3.1-23	MC74HC589	3.1-37
MC74F257A	3.1-33	MC74HC74A	3.1-23	MC74HC589A	3.1-37
MC74F258A	3.1-33	MC74HC75	3.1-30	MC74HC595A	3.1-37
MC74F259	3.1-30	MC74HC76	3.1-23	MC74HC597	3.1-37
MC74F269	3.1-18	MC74HC85	3.1-17	MC74HC597A	3.1-37
MC74F280	3.1-34	MC74HC86	3.1-27	MC74HC640A	3.1-15
MC74F283	3.1-13	MC74HC86A	3.1-27	MC74HC646	3.1-16
MC74F299	3.1-37	MC74HC107	3.1-23	MC74HC688	3.1-18
MC74F323	3.1-37	MC74HC109	3.1-23	MC74HC4002	3.1-28
MC74F350	3.1-37	MC74HC112	3.1-23	MC74HC4016	3.1-33
MC74F352	3.1-32	MC74HC125A	3.1-16	MC74HC4017	3.1-19
MC74F353	3.1-32	MC74HC126A	3.1-16	MC74HC4020A	3.1-18
MC74F365	3.1-14	MC74HC132A	3.1-36	MC74HC4024	3.1-33
MC74F366	3.1-14	MC74HC133	3.1-25	MC74HC4040A	3.1-18
MC74F367	3.1-14	MC74HC137	3.1-20	MC74HC4046A	3.1-39
MC74F368	3.1-14	MC74HC138A	3.1-20	MC74HC4049	3.1-29
MC74F373	3.1-30	MC74HC139A	3.1-21	MC74HC4050	3.1-29
MC74F374	3.1-24	MC74HC147	3.1-22	MC74HC4051	3.1-31
MC74F377	3.1-24	MC74HC151	3.1-31	MC74HC4052	3.1-32
MC74F378	3.1-36	MC74HC153	3.1-32	MC74HC4053	3.1-33
MC74F379	3.1-25	MC74HC154	3.1-20	MC74HC4060	3.1-18
MC74F381	3.1-13	MC74HC157A	3.1-32	MC74HC4060A	3.1-18
MC74F382	3.1-13	MC74HC158	3.1-32	MC74HC4066	3.1-33
MC74F398	3.1-33	MC74HC158A	3.1-32	MC74HC4075	3.1-29
MC74F399	3.1-33	MC74HC160	3.1-19	MC74HC4078	3.1-27
MC74F521	3.1-18	MC74HC161A	3.1-19	MC74HC4316	3.1-33
MC74F533	3.1-30	MC74HC162	3.1-19	MC74HC4351	3.1-31
MC74F534	3.1-24	MC74HC163	3.1-19	MC74HC4353	3.1-33
MC74F537	3.1-20	MC74HC164	3.1-37	MC74HC4511	3.1-21



# Device Index

Device Index	Page	Device Index	Page	Device Index	Page
MC74HC4514	3.1-20	MC78BC00	4.2-6	MC100E150	3.1-30
MC74HC4538A	3.1-33	MC78BC00N	4.2-6	MC100E151	3.1-22
MC74HC4851A	3.1-31	MC78BC30NTR	4.2-6	MC100E154	3.1-30
MC74HC4852A	3.1-31	MC78BC33NTR	4.2-6	MC100E155	3.1-30
MC74HC4853A	3.1-31	MC78BC50NTR	4.2-6	MC100E156	3.1-30
MC74HC7266	3.1-27	MC78FC00	4.2-6	MC100E157	3.1-33
MC74HC7266A	3.1-27	MC78FC00H	4.2-6	MC100E158	3.1-31
MC74HCT00A	3.1-26	MC78FC30HT1	4.2-6	MC100E160	3.1-34
MC74HCT04A	3.1-29	MC78FC33HT1	4.2-6	MC100E163	3.1-31
MC74HCT08A	3.1-25	MC78FC40HT1	4.2-6	MC100E164	3.1-31
MC74HCT14A	3.1-36	MC78FC40NTR	4.2-6	MC100E166	3.1-18
MC74HCT32A	3.1-28	MC78FC50HT1	4.2-6	MC100E167	3.1-22
MC74HCT74A	3.1-23	MC78L24AB	4.2-2	MC100E171	3.1-31
MC74HCT138A	3.1-20	MC78L24AC	4.2-2	MC100E175	3.1-30
MC74HCT157A	3.1-32	MC78L24C	4.2-2	MC100E193	3.1-34
MC74HCT161A	3.1-19	MC78LC00	4.2-5	MC100E195	3.1-35
MC74HCT163A	3.1-19	MC78LC00H	4.2-5	MC100E196	3.1-35
MC74HCT174A	3.1-23	MC78LC00N	4.2-5	MC100E210	3.1-13
MC74HCT240A	3.1-15	MC78LC30HT1	4.2-5	MC100E211	3.1-16
MC74HCT241A	3.1-15	MC78LC30NTR	4.2-5	MC100E212	3.1-36
MC74HCT244A	3.1-15	MC78LC33HT1	4.2-5	MC100E241	3.1-37
MC74HCT245A	3.1-14	MC78LC33NTR	4.2-5	MC100E256	3.1-30
MC74HCT273A	3.1-24	MC78LC40HT1	4.2-5	MC100E310	3.1-13
MC74HCT373A	3.1-30	MC78LC40NTR	4.2-5	MC100E336	3.1-14
MC74HCT374A	3.1-24	MC78LC50HT1	4.2-5	MC100E337	3.1-14
MC74HCT541A	3.1-15	MC78LC50NTR	4.2-5	MC100E404	3.1-27
MC74HCT573A	3.1-31	MC78LXXAB	4.2-2	MC100E416	3.1-35
MC74HCT574A	3.1-24	MC78LXXAC	4.2-2	MC100E431	3.1-22
MC74HCU04	3.1-29	MC78LXXC	4.2-2	MC100E445	3.1-18
MC74LCX00	3.1-25	MC78MXXB	4.2-2	MC100E446	3.1-18
MC74LCX02	3.1-28	MC78MXXC	4.2-2	MC100E451	3.1-22
MC74LCX04	3.1-29	MC78T15AC	4.2-3	MC100E452	3.1-22
MC74LCX08	3.1-25	MC78T15C	4.2-3	MC100E457	3.1-33
MC74LCX32	3.1-28	MC78TXXAC	4.2-3	MC100EL01	3.1-26
MC74LCX86	3.1-27	MC78TXXC	4.2-3	MC100EL04	3.1-26
MC74LCX125	3.1-13	MC78XXAC	4.2-3	MC100EL05	3.1-26
MC74LCX138	3.1-21	MC78XXB	4.2-3	MC100EL07	3.1-26
MC74LCX240	3.1-13	MC78XXC	4.2-3	MC100EL11	3.1-16
MC74LCX244	3.1-13	MC79L05AB	4.2-2	MC100EL12	3.1-29
MC74LCX245	3.1-38	MC79L05AC	4.2-2	MC100EL13	3.1-13
MC74LCX373	3.1-30	MC79L05C	4.2-2	MC100EL14	3.1-16
MC74LCX374	3.1-24	MC79L24AB	4.2-2	MC100EL15	3.1-16
MC74LCX540	3.1-13	MC79L24AC	4.2-2	MC100EL16	3.1-35
MC74LCX541	3.1-13	MC79L24C	4.2-2	MC100EL17	3.1-35
MC74LCX573	3.1-30	MC79LXXAB	4.2-2	MC100EL29	3.1-23
MC74LCX574	3.1-24	MC79LXXAC	4.2-2	MC100EL30	3.1-25
MC74LCX16240A	3.1-13	MC79LXXC	4.2-2	MC100EL31	3.1-22
MC74LCX16244	3.1-13	MC79MXXB	4.2-2	MC100EL32	3.1-21
MC74LCX16245	3.1-38	MC79MXXC	4.2-2	MC100EL33	3.1-21
MC74LCX16373	3.1-30	MC79XXAC	4.2-3	MC100EL34	3.1-17
MC74LCX16374	3.1-24	MC79XXC	4.2-3	MC100EL35	3.1-23
MC74LCX16543A	3.1-38	MC88LV926	3.1-17	MC100EL38	3.1-17
MC74LVQ00	3.1-25	MC88PL117	3.1-17	MC100EL39	3.1-17
MC74LVQ04	3.1-29	MC100E016	3.1-19	MC100EL51	3.1-22
MC74LVQ32	3.1-28	MC100E101	3.1-27	MC100EL52	3.1-22
MC74LVQ125	3.1-14	MC100E104	3.1-27	MC100EL56	3.1-32
MC74LVQ138	3.1-21	MC100E107	3.1-27	MC100EL57	3.1-31
MC74LVQ240	3.1-14	MC100E111	3.1-16	MC100EL58	3.1-31
MC74LVQ244	3.1-13	MC100E112	3.1-29	MC100EL59	3.1-33
MC74LVQ245	3.1-38	MC100E116	3.1-35	MC100EL90	3.1-39
MC74LVQ373	3.1-30	MC100E122	3.1-29	MC100ELT20	3.1-39
MC74LVQ374	3.1-24	MC100E131	3.1-22	MC100ELT21	3.1-38
MC74LVQ541	3.1-13	MC100E136	3.1-18	MC100ELT22	3.1-38
MC74LVQ573	3.1-30	MC100E137	3.1-19	MC100ELT23	3.1-38
MC74LVQ574	3.1-24	MC100E141	3.1-37	MC100ELT24	3.1-39
MC74LVQ646	3.1-38	MC100E142	3.1-37	MC100ELT25	3.1-38
MC74LVQ652	3.1-38	MC100E143	3.1-22	MC100ELT28	3.1-39

# Device Index

Device Index	Page	Device Index	Page	Device Index	Page
MC100H600	3.1-38	MC944	3.1-22	MC3399	4.9-3
MC100H601	3.1-38	MC945	3.1-22	MC3399DW	4.3-4
MC100H602	3.1-38	MC946	3.1-26	MC3399T	4.3-4
MC100H603	3.1-38	MC951	3.1-33	MC3403	4.1-4
MC100H604	3.1-39	MC952	3.1-23	MC3405	4.1-6, 4.1-7
MC100H605	3.1-39	MC953	3.1-23	MC3418	4.7-34, 4.7-36
MC100H606	3.1-39	MC1016	3.1-6	MC3418DW	4.7-34
MC100H607	3.1-39	MC1350	4.1-5, 4.8-3	MC3418P	4.7-34
MC100H640	3.1-17	MC1350D	4.1-5	MC3419	4.7-12
MC100H641	3.1-17	MC1374	4.8-4, 4.8-17	MC3423D	4.2-27
MC100H642	3.1-17	MC1378	4.8-3	MC3423P1	4.2-27
MC100H643	3.1-17	MC1391	4.8-3	MC3425	4.2-27
MC100H644	3.1-17	MC1403	4.4-2	MC3425P1	4.2-27
MC100H646	3.1-17	MC1403A	4.4-2	MC3456P	4.10-2
MC100H660	3.1-31	MC1404P5	4.4-2	MC3458	4.1-3
MC100H680	3.1-38	MC1404P6	4.4-2	MC3476	4.1-2
MC100H681	3.1-38	MC1404P10	4.4-2	MC3479	4.3-9
MC100LVE111	3.1-16	MC1413	4.6-8	MC3479FN	4.3-9
MC100LVE164	3.1-32	MC1413B	4.6-8	MC3479P	4.3-9
MC100LVE210	3.1-13	MC1416	4.6-8	MC4016	3.1-20, 4.7-39
MC100LVE222	3.1-17	MC1416B	4.6-8	MC4018	3.1-20, 4.7-39
MC100LVE310	3.1-13	MC1436	4.1-2	MC4024	3.1-33, 4.7-39
MC100LVEL01	3.1-26	MC1436C	4.1-2	MC4044	3.1-21, 4.7-39
MC100LVEL11	3.1-13	MC1455BP1	4.10-2	MC4316	3.1-20, 4.7-39
MC100LVEL13	3.1-13	MC1455D	4.10-2	MC4324	3.1-33, 4.7-39
MC100LVEL14	3.1-16	MC1455P1	4.10-2	MC4344	3.1-21, 4.7-39
MC100LVEL16	3.1-35	MC1458	4.1-3	MC4558AC	4.1-3
MC100LVEL17	3.1-35	MC1458C	4.1-3	MC4558C	4.1-3
MC100LVEL29	3.1-23	MC1488	4.6-7	MC4741C	4.1-4
MC100LVEL30	3.1-25	MC1489	4.6-7	MC6801	2.6-10, 2.6-23
MC100LVEL31	3.1-24	MC1489A	4.6-7	MC6801U4	2.6-10, 2.6-23
MC100LVEL32	3.1-21	MC1490	4.1-5	MC6802	2.6-10
MC100LVEL33	3.1-21	MC1494P	4.10-2	MC6803	2.6-10, 2.6-23
MC100LVEL38	3.1-17	MC1495BP	4.10-2	MC6803U4	2.6-10, 2.6-23
MC100LVEL39	3.1-17	MC1495D	4.10-2	MC6805P2	2.6-11
MC100LVEL51	3.1-22	MC1495P	4.10-2	MC6805P6	2.6-11
MC100LVEL56	3.1-32	MC1496	4.7-4	MC6805R2	2.6-11, 2.6-25
MC100LVEL59	3.1-33	MC1648	3.1-34	MC6805R3	2.6-11, 2.6-25
MC100LVEL90	3.1-39	MC1650	3.1-18	MC6805R6	2.6-11
MC100LVEL91	3.1-39	MC1651	3.1-18	MC6805S2	2.6-11
MC100LVEL92	3.1-39	MC1658	3.1-33	MC6805S3	2.6-11
MC100LVELT22	3.1-38	MC1660	3.1-27	MC6805U2	2.6-11
MC100SX1230	3.1-22	MC1662	3.1-28	MC6805U3	2.6-11
MC660	3.1-22	MC1670	3.1-24	MC6845	2.6-10
MC661	3.1-22	MC1672	3.1-27	MC7824AC	4.2-3
MC662	3.1-22	MC1692	3.1-35	MC7824B	4.2-3
MC663	3.1-23	MC1723C	4.2-5	MC7824C	4.2-3
MC664	3.1-24	MC1741C	4.1-2	MC7924C	4.2-3
MC667	3.1-33	MC1776C	4.1-2	MC8106	5.8-6
MC668	3.1-29	MC2833	4.7-3	MC10100	3.1-28
MC669	3.1-22	MC3302	4.1-7	MC10101	3.1-27
MC670	3.1-29	MC3303	4.1-4	MC10102	3.1-28
MC671	3.1-29	MC3334	4.9-2	MC10103	3.1-28
MC672	3.1-29	MC3335	4.7-3	MC10104	3.1-25
MC677	3.1-29	MC3346	4.8-4	MC10105	3.1-27
MC678	3.1-29	MC3356	4.7-2	MC10106	3.1-28
MC830	3.1-25	MC3357	4.7-2	MC10107	3.1-27
MC832	3.1-13	MC3358	4.1-3	MC10109	3.1-27
MC836	3.1-29	MC3359	4.7-2	MC10110	3.1-28
MC837	3.1-29	MC3362	4.7-3	MC10111	3.1-28
MC840	3.1-29	MC3363	4.7-3	MC10113	3.1-27
MC844	3.1-22	MC3371	4.7-2	MC10114	3.1-36
MC845	3.1-22	MC3372	4.7-2	MC10115	3.1-35
MC846	3.1-26	MC3392	4.9-3, 4.9-7	MC10116	3.1-36
MC849	3.1-26	MC3392DW	4.9-7	MC10117	3.1-27
MC936	3.1-29	MC3392T	4.9-7	MC10118	3.1-27
MC937	3.1-29	MC3392T-1	4.9-7	MC10119	3.1-26

# Device Index

<u>Device Index</u>	<u>Page</u>	<u>Device Index</u>	<u>Page</u>	<u>Device Index</u>	<u>Page</u>
MC10121	3.1-26	MC12022A	3.1-34, 4.7-39	MC13077	4.8-3, 4.8-6, 4.8-17, 4.8-23
MC10123	3.1-16	MC12022B	3.1-34, 4.7-39	MC13077DW	4.8-23
MC10124	3.1-39	MC12022LVA	3.1-34, 4.7-40	MC13077P	4.8-23
MC10125	3.1-39	MC12022LVB	3.1-34, 4.7-40	MC13081X	4.8-4
MC10128	3.1-14	MC12022SLA	3.1-34, 4.7-40	MC13109	4.7-3, 4.7-4
MC10129	3.1-35	MC12022SLB	3.1-34, 4.7-40	MC13109FB	4.7-4
MC10130	3.1-30	MC12022TSA	3.1-34, 4.7-40	MC13109FTA	4.7-4
MC10131	3.1-23	MC12022TSB	3.1-34, 4.7-40	MC13110	4.7-3, 4.7-5
MC10132	3.1-32	MC12022TVA	3.1-34, 4.7-40	MC13110FB	4.7-5
MC10133	3.1-31	MC12022TVB	3.1-34, 4.7-40	MC13111	4.7-3
MC10134	3.1-32	MC12023	3.1-35, 4.7-40	MC13122	4.8-2
MC10135	3.1-23	MC12025	3.1-35, 4.7-40	MC13135	4.7-3, 4.7-6
MC10136	3.1-20	MC12026A	3.1-34, 4.7-40	MC13135DW	4.7-6
MC10137	3.1-20	MC12026B	3.1-34, 4.7-40	MC13135P	4.7-6
MC10138	3.1-19	MC12028A	3.1-34, 4.7-40	MC13136	4.7-3, 4.7-6
MC10141	3.1-37	MC12028B	3.1-34, 4.7-40	MC13136DW	4.7-6
MC10153	3.1-31	MC12031A	3.1-35, 4.7-40	MC13136P	4.7-6
MC10154	3.1-19	MC12031B	3.1-35, 4.7-40	MC13141	4.7-2
MC10158	3.1-32	MC12032A	3.1-35, 4.7-40	MC13142	4.7-2
MC10159	3.1-32	MC12032B	3.1-35, 4.7-40	MC13143	4.7-2
MC10160	3.1-34	MC12033A	3.1-35, 4.7-40	MC13144	4.7-2
MC10161	3.1-20	MC12033B	3.1-35, 4.7-40	MC13150	4.7-2, 4.7-7
MC10162	3.1-20	MC12034A	3.1-35, 4.7-40	MC13150FTA	4.7-7
MC10163	3.1-21	MC12034B	3.1-35, 4.7-40	MC13150FTB	4.7-7
MC10164	3.1-31	MC12036A	3.1-34, 4.7-40	MC13155	4.7-2
MC10165	3.1-22	MC12036B	3.1-34, 4.7-40	MC13156	4.7-2, 4.7-8
MC10166	3.1-18	MC12038A	3.1-34	MC13156DW	4.7-8
MC10168	3.1-31	MC12040	3.1-21, 4.7-40	MC13156FB	4.7-8
MC10170	3.1-34	MC12052A	3.1-34	MC13158	4.7-2
MC10171	3.1-20	MC12053A	3.1-34	MC13158FTB	4.7-9
MC10172	3.1-21	MC12054A	3.1-35	MC13159	4.7-2
MC10173	3.1-33	MC12058	3.1-34	MC13173	4.7-4
MC10174	3.1-32	MC12061	3.1-33, 4.7-40	MC13175	4.7-3, 4.7-10
MC10175	3.1-31	MC12066	3.1-34	MC13175D	4.7-10
MC10176	3.1-23	MC12073	3.1-34, 4.7-40	MC13176	4.7-3, 4.7-10
MC10177	3.1-39	MC12074	3.1-34, 4.7-40	MC13176D	4.7-10
MC10178	3.1-19	MC12075	3.1-34	MC13280AY	4.8-4
MC10180	3.1-13	MC12076	3.1-35, 4.7-40	MC13281A	4.8-4
MC10181	3.1-13	MC12078	3.1-35, 4.7-40	MC13281B	4.8-4
MC10186	3.1-23	MC12079	3.1-35, 4.7-40	MC13282A	4.8-4
MC10188	3.1-29	MC12080	3.1-34, 4.7-40	MC13283	4.8-4
MC10189	3.1-29	MC12083	3.1-34, 4.7-40	MC14000UB	3.1-28
MC10190	3.1-39	MC12089	3.1-35, 4.7-40	MC14001B	3.1-28
MC10191	3.1-38	MC12090	3.1-35, 4.7-40	MC14001UB	3.1-28
MC10192	3.1-16	MC12093	3.1-34	MC14002B	3.1-28
MC10193	3.1-21	MC12095	3.1-35	MC14002UB	3.1-28
MC10195	3.1-29	MC12098	3.1-35	MC14006B	3.1-36
MC10197	3.1-25	MC12100	3.1-33, 4.7-40	MC14007UB	3.1-29
MC10198	3.1-33	MC12101	3.1-33, 4.7-40	MC14008B	3.1-13
MC10210	3.1-28	MC12147	3.1-39	MC14011B	3.1-26
MC10211	3.1-28	MC12148	3.1-33, 4.7-40	MC14011UB	3.1-26
MC10212	3.1-27	MC12149	3.1-39	MC14012B	3.1-25
MC10216	3.1-35	MC12179	3.1-38	MC14012UB	3.1-25
MC10231	3.1-23	MC12181	3.1-38	MC14013B	3.1-22
MC10319	4.5-2, 4.8-4	MC12202	3.1-38	MC14014B	3.1-37
MC10804	3.1-38	MC12206	3.1-38	MC14015B	3.1-37
MC10805	3.1-38	MC12210	3.1-38	MC14016B	3.1-33
MC12002	3.1-21, 4.7-39	MC12429	3.1-17	MC14017B	3.1-19
MC12009	3.1-35, 4.7-39	MC12439	3.1-17	MC14018B	3.1-19
MC12011	3.1-35, 4.7-39	MC13022A	4.8-2	MC14020B	3.1-18
MC12013	3.1-35, 4.7-39	MC13025	4.8-2	MC14020B	3.1-18
MC12014	3.1-19, 4.7-39	MC13027	4.8-2	MC14021B	3.1-37
MC12015	3.1-35, 4.7-39	MC13028A	4.8-2	MC14022B	3.1-19
MC12016	3.1-35, 4.7-39	MC13029A	4.8-2	MC14023B	3.1-26
MC12017	3.1-35, 4.7-39	MC13030	4.8-2	MC14023UB	3.1-26
MC12018	3.1-35, 4.7-39	MC13055	4.7-2	MC14024B	3.1-18
MC12019	3.1-35, 4.7-39	MC13060	4.7-36, 4.8-2	MC14025B	3.1-28

# Device Index

<u>Device Index</u>	<u>Page</u>	<u>Device Index</u>	<u>Page</u>	<u>Device Index</u>	<u>Page</u>
MC14025UB	3.1-28	MC14518B	3.1-19	MC33065	4.2-23
MC14027B	3.1-23	MC14519B	3.1-26	MC33066	4.2-15
MC14028B	3.1-20	MC14520B	3.1-19	MC33067	4.2-15
MC14029B	3.1-19	MC14521B	3.1-34	MC33071	4.1-2
MC14035B	3.1-37	MC14522B	3.1-19	MC33071A	4.1-2
MC14038B	3.1-13	MC14526B	3.1-19	MC33072	4.1-3
MC14040B	3.1-18	MC14527B	3.1-13	MC33072A	4.1-3
MC14042B	3.1-31	MC14528B	3.1-33	MC33074	4.1-4
MC14043B	3.1-31	MC14529B	3.1-32	MC33074A	4.1-4
MC14044B	3.1-31	MC14530B	3.1-27	MC33076	4.1-3
MC14046B	3.1-34	MC14531B	3.1-34	MC33077	4.1-3
MC14049B	3.1-29	MC14532B	3.1-21	MC33078	4.1-3
MC14049UB	3.1-29	MC14534B	3.1-18	MC33079	4.1-4
MC14050B	3.1-29	MC14536B	3.1-34	MC33091	4.9-8
MC14051B	3.1-31	MC14538B	3.1-33	MC33091A	4.9-3
MC14052B	3.1-32	MC14539B	3.1-32	MC33091AD	4.9-8
MC14053B	3.1-33	MC14541B	3.1-34	MC33091AP	4.9-8
MC14060B	3.1-18	MC14543B	3.1-21, 4.6-9	MC33092	4.9-2
MC14066B	3.1-33	MC14544B	3.1-21, 4.6-9	MC33092DW	4.9-12
MC14067B	3.1-31	MC14547B	3.1-21, 4.6-9	MC33093	4.9-2
MC14068B	3.1-25	MC14549B	3.1-38, 4.5-2	MC33094	4.9-2
MC14069UB	3.1-29	MC14551B	3.1-32	MC33095	4.9-3
MC14070B	3.1-27	MC14553B	3.1-18	MC33102	4.1-3
MC14071B	3.1-28	MC14555B	3.1-21	MC33110	4.7-36
MC14072B	3.1-28	MC14556B	3.1-21	MC33111	4.7-36
MC14073B	3.1-26	MC14557B	3.1-36	MC33120	4.7-11, 4.7-12,
MC14075B	3.1-29	MC14558B	3.1-21, 4.6-9		4.7-15, 4.7-35
MC14076B	3.1-25	MC14559B	3.1-38, 4.5-2	MC33120FN	4.7-11
MC14077B	3.1-27	MC14560B	3.1-13	MC33120P	4.7-11
MC14078B	3.1-28	MC14561B	3.1-13	MC33121	4.7-11, 4.7-35
MC14081B	3.1-25	MC14562B	3.1-36	MC33121FN	4.7-11
MC14082B	3.1-25	MC14566B	3.1-19	MC33121P	4.7-11
MC14093B	3.1-36	MC14568B	3.1-19	MC33128	4.2-8, 4.2-10
MC14094B	3.1-37	MC14569B	3.1-19	MC33128D	4.2-10
MC14099B	3.1-30	MC14572UB	3.1-27	MC33129	4.2-12
MC14106B	3.1-36	MC14573	4.1-6	MC33143	4.9-6
MC14161B	3.1-18	MC14574	4.1-7	MC33143DW	4.9-6
MC14163B	3.1-18	MC14575	4.1-6, 4.1-7	MC33151D	4.2-38
MC14174B	3.1-23	MC14576C	4.1-6, 4.8-4	MC33151P	4.2-38
MC14175B	3.1-25	MC14577C	4.1-6, 4.8-4	MC33152D	4.2-38
MC14194B	3.1-37	MC14578	4.1-7, 4.10-3	MC33152P	4.2-38
MC14415	3.1-34	MC14580B	3.1-36	MC33153	4.2-38
MC14433	4.5-2	MC14583B	3.1-36	MC33153D	4.2-38
MC14443	4.5-2	MC14584B	3.1-36	MC33153P	4.2-38
MC14447	4.5-2	MC14585B	3.1-17	MC33154D	4.2-39
MC14467-1	4.10-3	MC14598B	3.1-30	MC33154P	4.2-39
MC14468	4.10-3	MC14599B	3.1-30	MC33160	4.2-2, 4.2-8
MC14470	4.10-3	MC14618	2.6-11	MC33160DW	4.2-9
MC14489	4.6-9	MC33023	4.2-13	MC33160P	4.2-9
MC14490	3.1-13	MC33025	4.2-15	MC33161	4.2-31
MC14495-1	4.6-9	MC33030DW	4.3-8	MC33161D	4.2-31
MC14499	4.6-9	MC33030P	4.3-8	MC33161P	4.2-31
MC14500B	3.1-29	MC33033	4.3-4, 4.3-5, 4.3-7	MC33163	4.2-14
MC14501UB	3.1-27	MC33033DW	4.3-5	MC33164	4.2-30
MC14502B	3.1-29	MC33033P	4.3-5	MC33164D-3	4.2-30
MC14503B	3.1-14	MC33035	4.3-4, 4.3-5, 4.3-6	MC33164D-5	4.2-30
MC14504B	3.1-38	MC33035DW	4.3-6	MC33164DM-3	4.2-30
MC14506UB	3.1-27	MC33035P	4.3-6	MC33164DM-5	4.2-30
MC14508B	3.1-30	MC33039	4.3-7	MC33164P-3	4.2-30
MC14510B	3.1-19	MC33039D	4.3-7	MC33164P-5	4.2-30
MC14511B	3.1-21, 4.6-9	MC33039P	4.3-7	MC33165	4.2-14
MC14512B	3.1-31	MC33060A	4.2-12	MC33166	4.2-14
MC14513B	3.1-21, 4.6-9	MC33063A	4.2-14	MC33167	4.2-14
MC14514B	3.1-20	MC33064	4.2-30	MC33169	4.2-8, 4.2-10
MC14515B	3.1-20	MC33064D-5	4.2-30	MC33169DTB	4.2-10
MC14516B	3.1-19	MC33064DM-5	4.2-30	MC33171	4.1-2
MC14517B	3.1-38	MC33064P-5	4.2-30	MC33172	4.1-3

# Device Index

Device Index	Page	Device Index	Page	Device Index	Page
MC33174	4.1-5	MC33304	4.1-5	MC33464N-09ATR	4.2-28
MC33178	4.1-3	MC33340D	4.2-32	MC33464N-09CTR	4.2-28
MC33179	4.1-5	MC33340P	4.2-32	MC33464N-20ATR	4.2-28
MC33181	4.1-2	MC33341	4.2-33	MC33464N-20CTR	4.2-28
MC33182	4.1-3	MC33341D	4.2-33	MC33464N-27ATR	4.2-28
MC33184	4.1-5	MC33341P	4.2-33	MC33464N-27CTR	4.2-28
MC33192	4.9-3	MC33345	4.2-34	MC33464N-30ATR	4.2-28
MC33192DW	4.9-9	MC33345DTB	4.2-34	MC33464N-30CTR	4.2-28
MC33193	4.9-3, 4.9-9	MC33345DW	4.2-34	MC33464N-45ATR	4.2-28
MC33193D	4.9-9	MC33346	4.2-35	MC33464N-45CTR	4.2-28
MC33193P	4.9-9	MC33346DTB	4.2-35	MC33465	4.2-29
MC33197A	4.9-3, 4.9-10	MC33346DW	4.2-35	MC33465N	4.2-29
MC33197AD	4.9-10	MC33347	4.2-36	MC33465N-09ATR	4.2-29
MC33197AP	4.9-10	MC33347D	4.2-36	MC33465N-09CTR	4.2-29
MC33199	4.9-3, 4.9-11	MC33347DTB	4.2-36	MC33465N-20ATR	4.2-29
MC33199D	4.9-11	MC33348	4.2-37	MC33465N-20CTR	4.2-29
MC33201	4.1-2	MC33348D	4.2-37	MC33465N-27ATR	4.2-29
MC33202	4.1-4	MC33348D-1	4.2-37	MC33465N-27CTR	4.2-29
MC33204	4.1-5	MC33348D-2	4.2-37	MC33465N-30ATR	4.2-29
MC33206	4.1-4	MC33348D-3	4.2-37	MC33465N-30CTR	4.2-29
MC33207	4.1-5	MC33348D-4	4.2-37	MC33465N-45ATR	4.2-29
MC33215	4.7-35, 4.7-36	MC33348D-5	4.2-37	MC33465N-45CTR	4.2-29
MC33215B	4.7-29	MC33348D-6	4.2-37	MC33466	4.2-17
MC33215FB	4.7-29	MC33348DM	4.2-37	MC33466H	4.2-17
MC33218A	4.7-27, 4.7-30, 4.7-36	MC33348DM-1	4.2-37	MC33466H-30JT1	4.2-17
MC33218AP	4.7-27	MC33348DM-2	4.2-37	MC33466H-30LT1	4.2-17
MC33218DW	4.7-27	MC33348DM-3	4.2-37	MC33466H-33JT1	4.2-17
MC33219A	4.7-28, 4.7-30, 4.7-36	MC33348DM-4	4.2-37	MC33466H-33LT1	4.2-17
MC33219ADW	4.7-28	MC33348DM-5	4.2-37	MC33466H-50JT1	4.2-17
MC33219AP	4.7-28	MC33348DM-6	4.2-37	MC33466H-50LT1	4.2-17
MC33261	4.2-24	MC33362	4.2-15, 4.2-20	MC33466H-XXJT1	4.2-17
MC33262	4.2-24, 4.2-25	MC33362DW	4.2-20	MC33466H-XXLT1	4.2-17
MC33262D	4.2-25	MC33362P	4.2-20	MC34001	4.1-2
MC33262P	4.2-25	MC33363	4.2-15, 4.2-21	MC34001B	4.1-2
MC33264	4.2-7	MC33363A	4.2-15, 4.2-21	MC34002	4.1-3
MC33264D	4.2-7	MC33363ADW	4.2-21	MC34002B	4.1-3
MC33264D-2.8	4.2-7	MC33363DW	4.2-21	MC34004	4.1-4
MC33264D-3.0	4.2-7	MC33363P	4.2-21	MC34004B	4.1-4
MC33264D-3.3	4.2-7	MC33364	4.2-22	MC34010	4.7-19, 4.7-35
MC33264D-3.8	4.2-7	MC33364D	4.2-22	MC34010FN	4.7-19
MC33264D-4.0	4.2-7	MC33364D1	4.2-22	MC34010P	4.7-19
MC33264D-4.75	4.2-7	MC33364D2	4.2-22	MC34012-1	4.7-35
MC33264D-5.0	4.2-7	MC33368	4.2-24, 4.2-26	MC34012-2	4.7-35
MC33264DM	4.2-7	MC33368D	4.2-26	MC34012-3	4.7-35
MC33264DM-2.8	4.2-7	MC33463	4.2-16	MC34014	4.7-35
MC33264DM-3.0	4.2-7	MC33463H	4.2-16	MC34016	4.7-35
MC33264DM-3.3	4.2-7	MC33463H-30KT1	4.2-16	MC34016DW	4.7-22
MC33264DM-3.8	4.2-7	MC33463H-30LT1	4.2-16	MC34016P	4.7-22
MC33264DM-4.0	4.2-7	MC33463H-33KT1	4.2-16	MC34017	4.7-20
MC33264DM-4.75	4.2-7	MC33463H-33LT1	4.2-16	MC34017-1	4.7-35
MC33264DM-5.0	4.2-7	MC33463H-50KT1	4.2-16	MC34017-2	4.7-35
MC33267	4.2-2, 4.2-3, 4.2-8, 4.2-9, 4.9-2	MC33463H-50LT1	4.2-16	MC34017-3	4.7-35
MC33267T	4.2-9	MC33463H-XXKT1	4.2-16	MC34017D	4.7-20
MC33267TV	4.2-9	MC33463H-XXLT1	4.2-16	MC34017P	4.7-20
MC33269	4.2-5, 4.9-2	MC33464	4.2-28	MC34018	4.7-25, 4.7-30, 4.7-36
MC33269-XX	4.2-2, 4.2-3	MC33464H	4.2-28	MC34018DW	4.7-25
MC33272A	4.1-3	MC33464H-09AT1	4.2-28	MC34018P	4.7-25
MC33274A	4.1-5	MC33464H-09CT1	4.2-28	MC34023	4.2-13
MC33282	4.1-3	MC33464H-20AT1	4.2-28	MC34025	4.2-15
MC33284	4.1-5	MC33464H-20CT1	4.2-28	MC34055	4.6-8
MC33293A	4.9-3	MC33464H-27AT1	4.2-28	MC34055DW	4.6-3
MC33293AT	4.9-4	MC33464H-27CT1	4.2-28	MC34058	4.6-4, 4.6-7
MC33293ATV	4.9-4	MC33464H-30AT1	4.2-28	MC34058FTA	4.6-4
MC33298	4.9-3, 4.9-5	MC33464H-30CT1	4.2-28	MC34059	4.6-4, 4.6-7
MC33298DW	4.9-5	MC33464H-45AT1	4.2-28	MC34059FTA	4.6-4
MC33298P	4.9-5	MC33464H-45CT1	4.2-28	MC34060A	4.2-12
		MC33464N	4.2-28	MC34063A	4.2-14

# Device Index

Device Index	Page	Device Index	Page	Device Index	Page
MC34064	4.2-30	MC34217P	4.7-20	MC44825	4.8-4, 4.8-6, 4.8-10, 4.8-17, 4.8-20
MC34064D-5	4.2-30	MC34250	4.6-8	MC44825D	4.8-20
MC34064DM-5	4.2-30	MC34250FTA	4.6-5	MC44826	4.8-6, 4.8-10, 4.8-17
MC34064P-5	4.2-30	MC34261	4.2-24	MC44827	4.8-4, 4.8-6, 4.8-10, 4.8-17, 4.8-21
MC34065	4.2-23	MC34262	4.2-24, 4.2-25	MC44827DTB	4.8-21
MC34066	4.2-15	MC34262D	4.2-25	MC44828	4.8-4, 4.8-6, 4.8-10, 4.8-17, 4.8-21
MC34067	4.2-15	MC34262P	4.2-25	MC44828DTB	4.8-21
MC34071	4.1-2	MC34268	4.2-2, 4.2-3, 4.2-11	MC44829	4.8-4, 4.8-6, 4.8-10, 4.8-17, 4.8-22
MC34071A	4.1-2	MC34268D	4.2-11	MC44829D	4.8-22
MC34072	4.1-3	MC34268DT	4.2-11	MC44864	4.8-4, 4.8-6, 4.8-10, 4.8-17
MC34072A	4.1-3	MC34270	4.2-23	MC68000	4.7-17
MC34074	4.1-4	MC34271	4.2-23	MC68150*33	3.1-14
MC34074A	4.1-4	MC44002	4.8-3, 4.8-10, 4.8-11	MC68150*40	3.1-14
MC34080B	4.1-2	MC44002P	4.8-11	MC68160	4.6-2, 4.6-8
MC34081B	4.1-2	MC44007	4.8-3, 4.8-10, 4.8-11	MC68160FB	4.6-2
MC34082	4.1-3	MC44007P	4.8-11	MC68194	3.1-16
MC34083B	4.1-3	MC44011	4.8-3, 4.8-6, 4.8-7, 4.8-17	MC68302	4.7-15, 4.7-17
MC34084	4.1-4	MC44011FB	4.8-7	MC68331	2.6-21, 2.6-25
MC34085B	4.1-4	MC44011FN	4.8-7	MC68332	2.6-21, 2.6-25
MC34114	4.7-35	MC44030	4.8-3	MC68360	4.6-2, 4.6-8
MC34114DW	4.7-21	MC44035	4.8-3	MC68701	2.6-10, 2.6-23
MC34114P	4.7-21	MC44131	4.8-10	MC68701U4	2.6-10, 2.6-23
MC34115	4.7-34, 4.7-36	MC44140	4.8-3, 4.8-6, 4.8-10, 4.8-11	MC75172B	4.6-7
MC34115DW	4.7-34	MC44144	4.8-4	MC75174B	4.6-7
MC34115P	4.7-34	MC44145	4.8-3, 4.8-4, 4.8-6	MC79076	4.9-2
MC34118	4.7-26, 4.7-30, 4.7-36	MC44200	4.5-3, 4.8-3, 4.8-4, 4.8-6, 4.8-8	MC88100	2.3-2, 2.3-3
MC34118DW	4.7-26	MC44200FB	4.8-8	MC88110	2.3-2, 2.3-3
MC34118P	4.7-26	MC44251	4.5-2, 4.8-3, 4.8-4, 4.8-6, 4.8-9, 4.8-17	MC88110RC	2.3-2
MC34119	4.7-26, 4.7-27, 4.7-28, 4.7-30, 4.7-31, 4.7-36, 4.8-2	MC44251FN	4.8-9	MC88200	2.3-3
MC34119D	4.7-31	MC44251FU	4.8-9	MC88200RC	2.3-3
MC34119P	4.7-31	MC44302	4.8-6, 4.8-10, 4.8-17	MC88204RC	2.3-3
MC34129	4.2-12, 4.7-15, 4.7-36	MC44353	4.8-4	MC88410	2.3-3
MC34129D	4.7-31	MC44354	4.8-4	MC88913	3.1-17
MC34129P	4.7-31	MC44355	4.8-4	MC88914	3.1-17
MC34151	4.2-38	MC44361	4.8-6, 4.8-17	MC88915*55	3.1-17
MC34151D	4.2-38	MC44362	4.8-6, 4.8-17	MC88915*70	3.1-17
MC34151P	4.2-38	MC44365	4.8-6, 4.8-17	MC88915T*55	3.1-17
MC34152	4.2-38	MC44461	4.8-3, 4.8-6, 4.8-10, 4.8-17	MC88915T*70	3.1-17
MC34152D	4.2-38	MC44462	4.8-3, 4.8-6, 4.8-10, 4.8-17	MC88915T*100	3.1-17
MC34152P	4.2-38	MC44463	4.8-3, 4.8-6, 4.8-10, 4.8-17	MC88915T*133	3.1-17
MC34156	4.6-8	MC44602	4.2-13	MC88915T*160	3.1-17
MC34160	4.2-8, 4.2-9	MC44603	4.2-18, 4.8-10	MC88916*70	3.1-17
MC34160DW	4.2-9	MC44603D	4.2-18	MC88916*80	3.1-17
MC34160P	4.2-9	MC44604	4.2-18	MC88920	3.1-16
MC34161	4.2-31	MC44604P	4.2-18	MC88921	3.1-16
MC34161D	4.2-31	MC44605	4.2-19, 4.8-10	MC141620	4.8-3, 4.8-6, 4.8-10, 4.8-17
MC34161P	4.2-31	MC44605P	4.2-19	MC141621	4.8-12
MC34163	4.2-14	MC44702	4.8-6	MC141621A	4.8-3, 4.8-6, 4.8-10, 4.8-17
MC34164	4.2-30	MC44817	4.8-4, 4.8-6, 4.8-10, 4.8-17, 4.8-18, 4.8-19, 4.8-21	MC141621FB	4.8-12
MC34164D-3	4.2-30	MC44817B	4.8-4, 4.8-18	MC141622A	4.8-3, 4.8-6, 4.8-10, 4.8-17
MC34164D-5	4.2-30	MC44817BD	4.8-18	MC141622AFU	4.8-13
MC34164DM-3	4.2-30	MC44817D	4.8-18	MC141624	4.8-3, 4.8-6, 4.8-10, 4.8-17
MC34164DM-5	4.2-30	MC44818	4.8-4, 4.8-6, 4.8-10, 4.8-17, 4.8-19, 4.8-21	MC141627	4.8-3, 4.8-6, 4.8-10, 4.8-17
MC34164P-3	4.2-30	MC44818D	4.8-19	MC143120	2.7-2, 2.7-5, 2.7-7, 2.7-8
MC34164P-5	4.2-30	MC44824	4.8-4, 4.8-6, 4.8-10, 4.8-17, 4.8-20	MC143120B1DW	2.7-3
MC34165	4.2-14	MC44824D	4.8-20	MC143120DW	2.7-3
MC34166	4.2-14				
MC34167	4.2-14				
MC34181	4.1-2				
MC34182	4.1-3				
MC34184	4.1-4				
MC34216	4.7-35				
MC34216A	4.7-35				
MC34216DW	4.7-23				
MC34217	4.7-35				
MC34217D	4.7-20				

# Device Index

Device Index	Page	Device Index	Page	Device Index	Page
MC143120E2DW	2.7-3	MC145421	4.7-12	MCCF79076	4.9-2
MC143150	2.7-2, 2.7-3, 2.7-4, 2.7-5, 2.7-7	MC145421DW	4.7-19	MCCS142233	3.1-36
MC143150B1FU	2.7-3	MC145421P	4.7-19	MCCS142234	3.1-36
MC143150B1FU1	2.7-3	MC145422	4.7-12, 4.7-18, 4.7-19	MCCS142235	3.1-36
MC143150FU	2.7-3	MC145422DW	4.7-18	MCCS142236	3.1-36
MC143150FU1	2.7-3	MC145422P	4.7-18	MCCS142237	3.1-36
MC144110	4.5-3	MC145425	4.7-12	MCCS142238	3.1-36
MC144111	4.5-3	MC145425DW	4.7-19	MCH12140	3.1-21, 4.7-40
MC144112	4.5-3	MC145425P	4.7-19	MCK12140	3.1-21, 4.7-40
MC144143	4.8-4, 4.8-6, 4.8-10, 4.8-14, 4.8-17	MC145426	4.7-12, 4.7-18	MCM4L4100C	2.8-8
MC144143P	4.8-14	MC145426DW	4.7-18	MCM4L4400C	2.8-8
MC144144	4.8-4, 4.8-6, 4.8-10, 4.8-15, 4.8-17	MC145426P	4.7-18	MCM5L400A-C	2.8-8
MC144144P	4.8-15	MC145436A	4.7-15	MCM5L4100A	2.8-8
MC145000	4.6-9	MC145436AP	4.7-15	MCM5L4100A-V	2.8-8
MC145001	4.6-9	MC145436DW	4.7-15	MCM5L4400A	2.8-8
MC145010	4.10-3	MC145442DW	4.7-32	MCM5L4400A-V	2.8-8
MC145011	4.10-3	MC145442P	4.7-32	MCM32B116	2.8-9
MC145012	4.10-3	MC145443DW	4.7-32	MCM32B216	2.8-9
MC145013	4.10-3	MC145443P	4.7-32	MCM32BT116	2.8-9
MC145017	4.10-3	MC145444DW	4.7-32	MCM32BT216	2.8-9
MC145018	4.10-3	MC145444H	4.7-32	MCM32C400	2.8-9
MC145040	4.5-2	MC145446AFW	4.7-32	MCM32C800	2.8-9
MC145041	4.5-2	MC145447DW	4.7-33	MCM32CT400	2.8-9
MC145050	4.5-2	MC145447P	4.7-33	MCM32CT420	2.8-9
MC145051	4.5-2	MC145453	4.6-9	MCM32CT423	2.8-9
MC145053	4.5-2	MC145460EVK	4.7-33	MCM32CT800	2.8-9
MC145073	4.5-2, 4.8-6	MC145472	4.7-12	MCM32T100	2.8-9
MC145074	4.5-3, 4.8-6, 4.8-17	MC145474	4.7-12, 4.7-15, 4.7-17	MCM32T200	2.8-9
MC145076	4.5-3, 4.8-6, 4.8-17	MC145475	4.7-12, 4.7-15, 4.7-17	MCM36C200	2.8-10
MC145106	4.7-38	MC145480DW	4.7-12	MCM36C404	2.8-10
MC145145-2	4.7-38	MC145480P	4.7-12	MCM36C800	2.8-10
MC145146-2	4.7-38	MC145480SD	4.7-12	MCM36C804	2.8-10
MC145149	4.7-38	MC145488	4.7-15, 4.7-17	MCM40C400	2.8-10
MC145151-2	4.7-38	MC145488FN	4.7-17	MCM40C800	2.8-10
MC145152-2	4.7-38	MC145500	4.7-12, 4.7-15, 4.7-18	MCM62X308	2.8-3
MC145155-2	4.7-38	MC145502	4.7-12	MCM63P631	2.8-3
MC145156-2	4.7-38	MC145503	4.7-12	MCM63P733	2.8-3
MC145157-2	4.7-38	MC145505	4.7-12	MCM64BT116	2.8-10
MC145158-2	4.7-38	MC145532	4.7-12, 4.7-15, 4.7-32	MCM64BT216	2.8-10
MC145159-1	4.7-38	MC145532DW	4.7-32	MCM64PE32	2.8-6
MC145162	4.7-38	MC145532L	4.7-32	MCM64PE64	2.8-6
MC145162-1	4.7-38	MC145536	4.7-32	MCM67A618A	2.8-5
MC145165	4.7-38	MC145536EVK	4.7-14, 4.7-15	MCM67B618A	2.8-3
MC145166	4.7-38	MC145537EVK	4.7-14	MCM67C618A	2.8-3
MC145167	4.7-38	MC145554	4.7-12	MCM67M618A	2.8-3
MC145168	4.7-38	MC145557	4.7-12	MCM67Q709	2.8-3
MC145169	4.7-38	MC145564	4.7-12	MCM67Q709A	2.8-3
MC145170-1	4.7-38	MC145567	4.7-12	MCM67Q804	2.8-3
MC145173	4.7-38	MC145572	4.7-12, 4.7-15, 4.7-16	MCM67Q909	2.8-3
MC145190	4.7-39	MC145572EVK	4.7-17	MCM69C232	2.8-3
MC145191	4.7-39	MC145572FN	4.7-16	MCM69C432	2.8-3
MC145192	4.7-39	MC145572PB	4.7-16	MCM69D536	2.8-3
MC145200	4.7-39	MC145574	4.7-12, 4.7-15, 4.7-16	MCM69D618	2.8-3
MC145201	4.7-39	MC145574DW	4.7-16	MCM69F536A	2.8-3
MC145202	4.7-39	MC145574PB	4.7-16	MCM69F536B	2.8-3
MC145225	4.7-39	MC145583	4.6-8	MCM69F618A	2.8-3
MC145230	4.7-39	MC145705	4.6-8	MCM69F737	2.8-3
MC145403	4.6-7	MC145706	4.6-8	MCM69F819	2.8-3
MC145404	4.6-7	MC145707	4.6-8	MCM69L536	2.8-4
MC145405	4.6-7	MC146805E2	2.6-11	MCM69L537	2.8-4
MC145406	4.6-7, 4.7-15	MC146818A	2.6-11	MCM69L538	2.8-4
MC145407	4.6-7, 4.7-15	MC146823	2.6-11	MCM69L618	2.8-4
MC145408	4.6-7	MCA231	5.8-7	MCM69L619	2.8-4
		MCCF3334	4.9-2	MCM69L620	2.8-4
		MCCF33093	4.9-2	MCM69L736	2.8-4
		MCCF33094	4.9-2	MCM69L736A	2.8-4
		MCCF33095	4.9-3	MCM69L737	2.8-4

# Device Index

Device Index	Page	Device Index	Page	Device Index	Page
MCM69L737A	2.8-4	MCM6729D	2.8-5	MCR12LN	5.7-5
MCM69L738	2.8-4	MCM6926	2.8-5	MCR12M	5.7-5
MCM69L738A	2.8-4	MCM6926A	2.8-5	MCR12N	5.7-5
MCM69L818	2.8-4	MCM6929	2.8-5	MCR16D	5.7-5
MCM69L818A	2.8-4	MCM6929A	2.8-5	MCR16M	5.7-5
MCM69L819	2.8-4	MCM6943	2.8-5	MCR16N	5.7-5
MCM69L819A	2.8-4	MCM6946	2.8-5	MCR22-6	5.7-2
MCM69L820	2.8-4	MCM6949	2.8-5	MCR22-8	5.7-2
MCM69L820A	2.8-4	MCM10139	3.1-35	MCR25D	5.7-5
MCM69L821A	2.8-4	MCM10143	3.1-36	MCR25M	5.7-5
MCM69P536A	2.8-3	MCM10145	3.1-36	MCR25N	5.7-5
MCM69P536B	2.8-3	MCM10146	3.1-35	MCR69-2	5.7-6
MCM69P618A	2.8-3	MCM10149*25	3.1-35	MCR69-3	5.7-6
MCM69P737	2.8-3	MCM10152	3.1-35	MCR69-6	5.7-6
MCM69P819	2.8-3	MCM32100	2.8-9	MCR72-2	5.7-4
MCM69Q536	2.8-3	MCM32128A	2.8-6	MCR72-3	5.7-4
MCM69Q618	2.8-3	MCM32130	2.8-9	MCR72-4	5.7-4
MCM69R536	2.8-4	MCM32230	2.8-9	MCR72-6	5.7-4
MCM69R537	2.8-4	MCM32515	2.8-6	MCR72-8	5.7-4
MCM69R538	2.8-4	MCM36104	2.8-9	MCR72-10	5.7-4
MCM69R539	2.8-4	MCM36204	2.8-9	MCR100-6	5.7-2
MCM69R618	2.8-4	MCM40100	2.8-10	MCR100-8	5.7-2
MCM69R619	2.8-4	MCM40200	2.8-10	MCR106-2	5.7-3
MCM69R620	2.8-4	MCM44100C	2.8-8	MCR106-3	5.7-3
MCM69R621	2.8-4	MCM44400C	2.8-8	MCR106-4	5.7-3
MCM69R736	2.8-4	MCM54100A	2.8-8	MCR106-6	5.7-3
MCM69R736A	2.8-4	MCM54100A-C	2.8-8	MCR106-8	5.7-3
MCM69R737	2.8-4	MCM54100A-V	2.8-8	MCR218-4FP	5.7-4
MCM69R737A	2.8-4	MCM54400A	2.8-8	MCR218-6FP	5.7-4
MCM69R738	2.8-4	MCM54400A-C	2.8-8	MCR218-8FP	5.7-4
MCM69R738A	2.8-4	MCM54400A-V	2.8-8	MCR218-10FP	5.7-4
MCM69R739A	2.8-4	MCM56824A	2.8-5	MCR225-2FP	5.7-6
MCM69R818	2.8-4	MCM62110	2.3-3	MCR225-4FP	5.7-6
MCM69R818A	2.8-4	MCM62990A	2.8-3	MCR225-6FP	5.7-6
MCM69R819	2.8-4	MCM62995A	2.8-5	MCR225-8FP	5.7-6
MCM69R819A	2.8-4	MCM62996	2.8-5	MCR225-10FP	5.7-6
MCM69R820	2.8-4	MCM81430	2.8-9	MCR264-4	5.7-6
MCM69R820A	2.8-4	MCM84000	2.8-9	MCR264-6	5.7-6
MCM69T618	2.8-3	MCM94000	2.8-9	MCR264-8	5.7-6
MCM72F6DG	2.8-6	MCM218160B	2.8-8	MCR264-10	5.7-6
MCM72F7DG	2.8-6	MCM218165B	2.8-8	MCR265-4	5.7-6
MCM72F8DG	2.8-6	MCM317400C	2.8-8	MCR265-6	5.7-6
MCM72F9DG	2.8-6	MCM321024	2.8-6	MCR265-8	5.7-6
MCM72F10DG	2.8-6	MCM417400	2.8-8	MCR265-10	5.7-6
MCM72F11DG	2.8-6	MCM417400B	2.8-8	MCR310-3	5.7-4
MCM84C430	2.8-9	MCM417405B	2.8-8	MCR310-4	5.7-4
MCM84CT430	2.8-9	MCM516400B	2.8-8	MCR310-6	5.7-4
MCM94C430	2.8-9	MCM517400B	2.8-8	MCR310-8	5.7-4
MCM94CT430	2.8-9	MCM517400C	2.8-8	MCR310-10	5.7-4
MCM6206BA	2.8-5	MCM517400CV	2.8-8	MCR716	5.7-3
MCM6226B	2.8-5	MCM517405C	2.8-8	MCR716-1	5.7-3
MCM6226BB	2.8-5	MCM517405CV	2.8-8	MCR718	5.7-3
MCM6227B	2.8-5	MCM518160B	2.8-8	MCR718-1	5.7-3
MCM6229B	2.8-5	MCM518165B	2.8-8	MCT2	5.8-6
MCM6229BB	2.8-5	MCM518165BV	2.8-8	MCT2E	5.8-6
MCM6246	2.8-5	MCR08BT1	5.7-2	MCT271	5.8-6
MCM6246A	2.8-5	MCR8D	5.7-4	MCT272	5.8-6
MCM6249	2.8-5	MCR08DT1	5.7-2	MCT275	5.8-6
MCM6249A	2.8-5	MCR8M	5.7-4	MDC3105LT1	5.1-43
MCM6323	2.8-5	MCR08MT1	5.7-2	MDC5000T1	5.1-43
MCM6706B	2.8-5	MCR8N	5.7-4	MDC5001T1	5.1-43
MCM6706BR	2.8-5	MCR8SD	5.7-4	MFF124B	5.10-39
MCM6726B	2.8-5	MCR8SM	5.7-4	MFF224B	5.10-39
MCM6726C	2.8-5	MCR8SN	5.7-4	MFF324B	5.10-38
MCM6726D	2.8-5	MCR12D	5.7-5	MFF424B	5.10-38
MCM6729B	2.8-5	MCR12LD	5.7-5	MFF524B	5.10-37
MCM6729C	2.8-5	MCR12LM	5.7-5	MG8MEVB16Y1	2.6-25



# Device Index

Device Index	Page	Device Index	Page	Device Index	Page
MGB20N35CL	5.4-7, 5.4-22	MHW851-2	5.10-32	MHW6292-6	5.10-38
MGB20N40CL	5.4-7, 5.4-22	MHW851-3	5.10-32	MHW6342	5.10-39
MGP5N60E	5.4-22	MHW851-4	5.10-32	MHW7142	5.10-37
MGP20N14CL	5.4-7, 5.4-22	MHW910	5.10-33	MHW7182	5.10-37
MGP20N35CL	5.4-7, 5.4-22	MHW913	5.10-33	MHW7185A	5.10-38
MGP20N40CL	5.4-7, 5.4-22	MHW914	5.10-33	MHW7185B	5.10-38
MGP20N60	5.4-22	MHW916	5.10-33	MHW7185C	5.10-38
MGR1018	5.6-14	MHW920	5.10-33	MHW7205A	5.10-38
MGR2018CT	5.6-14	MHW927B	5.10-33	MHW7205B	5.10-38
MGR2025CT	5.6-14	MHW930	5.10-33	MHW7205C	5.10-38
MGRB1018	5.6-14	MHW953	5.10-33	MHW7222	5.10-37
MGRB2018CT	5.6-14	MHW1134	5.10-40	MHW7242	5.10-37
MGRB2025CT	5.6-14	MHW1184	5.10-40	MHW7272	5.10-37
MG51100	5.9-12	MHW1184L	5.10-40	MHW7292	5.10-37
MGSF1N02LT1	5.1-24, 5.1-42	MHW1224	5.10-40	MHW8142	5.10-37
MGSF1N03LT1	5.1-24, 5.1-42	MHW1224L	5.10-40	MHW8182	5.10-37
MGSF1P02ELT1	5.1-24, 5.1-42	MHW1244	5.10-40	MHW8185	5.10-37
MGSF1P02LT1	5.1-24, 5.1-42	MHW1254L	5.10-40	MHW8205	5.10-37
MGSS150-1	5.7-14	MHW1304L	5.10-40	MHW8222	5.10-37
MGSS150-2	5.7-14	MHW1815	5.10-33	MHW8242	5.10-37
MGW12N120	5.4-22	MHW1916	5.10-33	MHW8272	5.10-37
MGW12N120D	5.4-22	MHW2607-1	5.10-31	MHW8292	5.10-37
MGW20N60D	5.4-22	MHW2627-1	5.10-31	MHW9005	5.10-33
MGW30N60	5.4-22	MHW2627-2	5.10-31	MHW9006	5.10-33
MGY25N120	5.4-22	MHW2701-1	5.10-31	MHW9014	5.10-32
MGY30N60D	5.4-22	MHW2701-2	5.10-31	MHW9182	5.10-36
MGY40N60	5.4-22	MHW2703	5.10-31	MHW9242	5.10-36
MGY40N60D	5.4-22	MHW2707-1	5.10-32	MIM2901	5.10-33
MHL8015	5.10-34	MHW2707-2	5.10-32	MIM2906	5.10-33
MHL8018	5.10-34	MHW2707A-1	5.10-32	MIM2908	5.10-33
MHL8115	5.10-34	MHW2707A-2	5.10-32	MJ413	5.5-12
MHL8118	5.10-34	MHW2717-1	5.10-32	MJ423	5.5-12
MHL9125	5.10-34	MHW2717-2	5.10-32	MJ802	5.5-13
MHL9128	5.10-34	MHW2723	5.10-31	MJ1000	5.5-11
MHL9232	5.10-34	MHW2727-1	5.10-32	MJ1001	5.5-11
MHL9236	5.10-34	MHW2727-2	5.10-32	MJ1302A	5.5-12, 5.5-15
MHLW8000	5.10-36	MHW2801	5.10-32	MJ2500	5.5-12
MHPM7A8A120A	5.3-2	MHW2803	5.10-32	MJ2501	5.5-12
MHPM7A12A120A	5.3-2	MHW2805-1	5.10-32	MJ2955	5.5-12
MHPM7A15A60A	5.3-2	MHW2805-2	5.10-32	MJ2955A	5.5-12, 5.5-15
MHPM7A16A120B	5.3-2	MHW2820-1	5.10-32	MJ3000	5.5-12
MHPM7A20A60A	5.3-2	MHW2820-2	5.10-32	MJ3001	5.5-12
MHPM7A25A120B	5.3-2	MHW2821-1	5.10-32	MJ3281A	5.5-12, 5.5-15
MHPM7A30A60B	5.3-2	MHW2821-2	5.10-32	MJ4502	5.5-13
MHW105	5.10-31	MHW2905	5.10-33	MJ10000	5.5-13
MHW590	5.10-34	MHW5142A	5.10-39	MJ10005	5.5-13
MHW591	5.10-34	MHW5172A	5.10-39	MJ10007	5.5-12
MHW592	5.10-34	MHW5182A	5.10-39	MJ10009	5.5-13
MHW593	5.10-34	MHW5185B	5.10-39	MJ10012	5.5-12
MHW607-1	5.10-31	MHW5222A	5.10-39	MJ10015	5.5-14
MHW607-2	5.10-31	MHW5225	5.10-39	MJ10016	5.5-14
MHW607-3	5.10-31	MHW5272A	5.10-39	MJ10020	5.5-14
MHW607-4	5.10-31	MHW5342A	5.10-39	MJ10021	5.5-14
MHW704-1	5.10-31	MHW5382A	5.10-39	MJ10022	5.5-14
MHW704-2	5.10-31	MHW6142	5.10-39	MJ10023	5.5-14
MHW707-1	5.10-31	MHW6172	5.10-39	MJ11011	5.5-13
MHW707-2	5.10-31	MHW6182	5.10-39	MJ11012	5.5-13
MHW707-3	5.10-31	MHW6182-6	5.10-38	MJ11013	5.5-13
MHW707-4	5.10-31	MHW6185-6A	5.10-38	MJ11014	5.5-13
MHW720A1	5.10-32	MHW6185B	5.10-39	MJ11015	5.5-13
MHW720A2	5.10-32	MHW6205	5.10-39	MJ11016	5.5-13
MHW803-1	5.10-32	MHW6205-6A	5.10-38	MJ11017	5.5-12
MHW803-2	5.10-32	MHW6222	5.10-39	MJ11018	5.5-12
MHW803-3	5.10-32	MHW6222-6	5.10-38	MJ11019	5.5-12
MHW804-1	5.10-32	MHW6225	5.10-39	MJ11020	5.5-12
MHW806A4	5.10-32	MHW6272	5.10-39	MJ11021	5.5-12
MHW851-1	5.10-32	MHW6272-6	5.10-38		



# Device Index

Device Index	Page	Device Index	Page	Device Index	Page
MMBF2201PT1	5.1-24	MMBV109LT1	5.1-29, 5.1-31	MMBZ5268BLT1	5.2-25, 5.2-29
MMBF2202PT1	5.1-42	MMBV409LT1	5.1-30, 5.1-31	MMBZ5269BLT1	5.2-25, 5.2-29
MMBF4391LT1	5.1-24	MMBV432LT1	5.1-25, 5.1-28	MMBZ5270BLT1	5.2-25, 5.2-29
MMBF4392LT1	5.1-24	MMBV609LT1	5.1-30, 5.1-32	MMDF1N05E	5.4-4, 5.4-8
MMBF4393LT1	5.1-24	MMBV809LT1	5.1-30, 5.1-31	MMDF2C01HD	5.4-4, 5.4-8
MMBF4416LT1	5.1-23	MMBV2101LT1	5.1-25, 5.1-28	MMDF2C02E	5.4-4, 5.4-8
MMBF4856LT1	5.1-24	MMBV2103LT1	5.1-28	MMDF2C02HD	5.4-4, 5.4-8
MMBF4860LT1	5.1-24	MMBV2104LT1	5.1-28	MMDF2C03HD	5.4-4, 5.4-8
MMBF5457LT1	5.1-23	MMBV2105LT1	5.1-25, 5.1-28	MMDF2N02E	5.4-4, 5.4-8
MMBF5459LT1	5.1-23	MMBV2107LT1	5.1-28	MMDF2P01HD	5.4-4, 5.4-17
MMBF5460LT1	5.1-23	MMBV2108LT1	5.1-28	MMDF2P02E	5.4-4, 5.4-17
MMBF5484LT1	5.1-23	MMBV2109LT1	5.1-25, 5.1-28	MMDF2P02HD	5.4-4, 5.4-17
MMBF5486LT1	5.1-23	MMBV3102LT1	5.1-30, 5.1-31	MMDF2P03HD	5.4-4, 5.4-17
MMBFJ175LT1	5.1-24	MMBV3401LT1	5.1-35, 5.1-36	MMDF3N02HD	5.4-4, 5.4-8
MMBFJ177LT1	5.1-24	MMBV3700LT1	5.1-35, 5.1-36	MMDF3N03HD	5.4-4, 5.4-8
MMBFJ309LT1	5.1-23	MMBZ5V6ALT1	5.2-9	MMDF4N01HD	5.4-4, 5.4-8
MMBFJ310LT1	5.1-23	MMBZ6V2ALT1	5.2-9	MMDF4N01Z	5.4-4, 5.4-9
MMBFU310LT1	5.1-23	MMBZ15ALT1	5.2-9	MMDF3055V	5.4-6
MMBR521LT1	5.10-18, 5.10-21	MMBZ15VDLT1	5.2-9	MMDF3055VL	5.4-6
MMBR571LT1	5.10-18, 5.10-21	MMBZ20ALT1	5.2-9	MMFT1N10E	5.4-9
MMBR901LT1	5.10-18, 5.10-21	MMBZ27VCLT1	5.2-9	MMFT2N02EL	5.4-9, 5.4-20
MMBR911LT1	5.10-18, 5.10-21	MMBZ5221BLT1	5.2-24, 5.2-28	MMFT107T1	5.1-24
MMBR920LT1	5.10-18, 5.10-22	MMBZ5222BLT1	5.2-24, 5.2-28	MMFT960T1	5.1-24
MMBR931LT1	5.10-18	MMBZ5223BLT1	5.2-24	MMFT2406T1	5.1-24
MMBR941LT1	5.10-18, 5.10-21	MMBZ5224BLT1	5.2-24	MMFT2955E	5.4-18
MMBR951ALT1	5.10-18	MMBZ5225BLT1	5.2-24, 5.2-28	MMFT3055E	5.4-9
MMBR951LT1	5.10-18, 5.10-21	MMBZ5226BLT1	5.2-24, 5.2-28	MMFT3055EL	5.4-9, 5.4-20
MMBR5031LT1	5.10-18, 5.10-22	MMBZ5227BLT1	5.2-24	MMFT3055V	5.4-6
MMBR5179LT1	5.10-18, 5.10-22	MMBZ5228BLT1	5.2-24, 5.2-28	MMFT3055VL	5.4-6
MMBT404ALT1	5.1-15	MMBZ5229BLT1	5.2-24, 5.2-28	MMFT6661T1	5.1-24
MMBT918LT1	5.1-14	MMBZ5230BLT1	5.2-24, 5.2-28	MMH0026	4.2-38
MMBT1010LT1	5.1-16, 5.1-41	MMBZ5231BLT1	5.2-24, 5.2-28	MMPQ2222A	5.1-9
MMBT2222ALT1	5.1-10	MMBZ5232BLT1	5.2-24, 5.2-28	MMPQ2369	5.1-9
MMBT2222AWT1	5.1-11	MMBZ5233BLT1	5.2-24, 5.2-28	MMPQ2907A	5.1-9
MMBT2369ALT1	5.1-14	MMBZ5234BLT1	5.2-24, 5.2-28	MMPQ3467	5.1-9
MMBT2369LT1	5.1-14	MMBZ5235BLT1	5.2-24, 5.2-28	MMPQ3725	5.1-9
MMBT2484LT1	5.1-15	MMBZ5236BLT1	5.2-24, 5.2-28	MMPQ3799	5.1-9
MMBT2907ALT1	5.1-10	MMBZ5237BLT1	5.2-24, 5.2-28	MMPQ3904	5.1-9
MMBT2907AWT1	5.1-11	MMBZ5238BLT1	5.2-24	MMPQ3906	5.1-9
MMBT3640LT1	5.1-14	MMBZ5239BLT1	5.2-24, 5.2-28	MMPQ6700	5.1-9
MMBT3904LT1	5.1-10	MMBZ5240BLT1	5.2-24, 5.2-28	MMQA5V6T1	5.2-10
MMBT3904WT1	5.1-11	MMBZ5241BLT1	5.2-24, 5.2-28	MMQA5V6T3	5.2-10
MMBT3906LT1	5.1-10	MMBZ5242BLT1	5.2-24, 5.2-28	MMQA6V2T1	5.2-10
MMBT3906WT1	5.1-11	MMBZ5243BLT1	5.2-24, 5.2-28	MMQA6V2T3	5.2-10
MMBT4401LT1	5.1-10	MMBZ5244BLT1	5.2-24, 5.2-28	MMQA6V8T1	5.2-10
MMBT4403LT1	5.1-10	MMBZ5245BLT1	5.2-24, 5.2-28	MMQA6V8T3	5.2-10
MMBT5087LT1	5.1-15	MMBZ5246BLT1	5.2-24, 5.2-28	MMQA12VT1	5.2-10
MMBT5089LT1	5.1-15	MMBZ5247BLT1	5.2-24, 5.2-28	MMQA12VT3	5.2-10
MMBT5401LT1	5.1-16	MMBZ5248BLT1	5.2-24, 5.2-28	MMQA13VT1	5.2-10
MMBT5551LT1	5.1-16	MMBZ5249BLT1	5.2-24, 5.2-28	MMQA13VT3	5.2-10
MMBT6428LT1	5.1-15	MMBZ5250BLT1	5.2-24, 5.2-28	MMQA15VT1	5.2-10
MMBT6429LT1	5.1-15	MMBZ5251BLT1	5.2-24, 5.2-28	MMQA15VT3	5.2-10
MMBT6517LT1	5.1-16	MMBZ5252BLT1	5.2-24, 5.2-28	MMQA18VT1	5.2-10
MMBT6520LT1	5.1-16	MMBZ5253BLT1	5.2-24, 5.2-28	MMQA18VT3	5.2-10
MMBT8599LT1	5.1-10	MMBZ5254BLT1	5.2-24, 5.2-28	MMQA20VT1	5.2-10
MMBTA06LT1	5.1-16	MMBZ5255BLT1	5.2-25, 5.2-28	MMQA20VT3	5.2-10
MMBTA13LT1	5.1-15	MMBZ5256BLT1	5.2-25, 5.2-28	MMQA21VT1	5.2-10
MMBTA14LT1	5.1-15	MMBZ5257BLT1	5.2-25, 5.2-28	MMQA21VT3	5.2-10
MMBTA42LT1	5.1-16	MMBZ5258BLT1	5.2-25, 5.2-28	MMQA22VT1	5.2-10
MMBTA56LT1	5.1-16	MMBZ5259BLT1	5.2-25, 5.2-28	MMQA22VT3	5.2-10
MMBTA64LT1	5.1-15	MMBZ5260BLT1	5.2-25	MMQA24VT1	5.2-10
MMBTA92LT1	5.1-16	MMBZ5261BLT1	5.2-25, 5.2-29	MMQA24VT3	5.2-10
MMBTH10LT1	5.1-14	MMBZ5262BLT1	5.2-25, 5.2-29	MMQA27VT1	5.2-10
MMBTH24LT1	5.1-14	MMBZ5263BLT1	5.2-25, 5.2-29	MMQA27VT3	5.2-10
MMBTH69LT1	5.1-14	MMBZ5264BLT1	5.2-25	MMQA30VT1	5.2-10
MMBTH81LT1	5.1-14	MMBZ5265BLT1	5.2-25, 5.2-29	MMQA30VT3	5.2-10
MMBV105GLT1	5.1-29, 5.1-31	MMBZ5266BLT1	5.2-25, 5.2-29	MMQA33VT1	5.2-10
		MMBZ5267BLT1	5.2-25		

# Device Index

Device Index	Page	Device Index	Page	Device Index	Page
MMQA33VT3	5.2-10	MMSZ4690T1	5.2-24, 5.2-31	MMSZ5260BT1	5.2-25, 5.2-30
MMSD71RKT1	5.1-36	MMSZ4691T1	5.2-24, 5.2-31	MMSZ5261BT1	5.2-25, 5.2-30
MMSD101T1	5.1-34	MMSZ4692T1	5.2-24, 5.2-31	MMSZ5262BT1	5.2-25, 5.2-30
MMSD301T1	5.1-34	MMSZ4693T1	5.2-24, 5.2-31	MMSZ5263BT1	5.2-25, 5.2-30
MMSD701T1	5.1-34	MMSZ4694T1	5.2-24, 5.2-31	MMSZ5264BT1	5.2-25, 5.2-30
MMSD914T1	5.1-36	MMSZ4695T1	5.2-24, 5.2-31	MMSZ5265BT1	5.2-25, 5.2-30
MMSD1000T1	5.1-37, 5.1-42	MMSZ4696T1	5.2-24, 5.2-31	MMSZ5266BT1	5.2-25, 5.2-30
MMSD4148T1	5.1-36	MMSZ4697T1	5.2-24, 5.2-31	MMSZ5267BT1	5.2-25, 5.2-30
MMSF2P02E	5.4-4, 5.4-17	MMSZ4698T1	5.2-24, 5.2-31	MMSZ5268BT1	5.2-25, 5.2-30
MMSF3P02HD	5.4-4, 5.4-17	MMSZ4699T1	5.2-24, 5.2-31	MMSZ5269BT1	5.2-25, 5.2-30
MMSF3P02Z	5.4-4, 5.4-17	MMSZ4700T1	5.2-24, 5.2-31	MMSZ5270BT1	5.2-25, 5.2-30
MMSF3P03HD	5.4-4, 5.4-17	MMSZ4701T1	5.2-24, 5.2-31	MMSZ5271BT1	5.2-25
MMSF4P01HD	5.4-4, 5.4-17	MMSZ4702T1	5.2-24, 5.2-31	MMT10V275	5.7-14
MMSF4P01Z	5.4-4, 5.4-17	MMSZ4703T1	5.2-24, 5.2-31	MMT10V400	5.7-14
MMSF5N02HD	5.4-4, 5.4-8	MMSZ4704T1	5.2-24, 5.2-31	MMUN2111LT1	5.1-12
MMSF5N03HD	5.4-4, 5.4-8	MMSZ4705T1	5.2-24, 5.2-31	MMUN2112LT1	5.1-12
MMSF5N03Z	5.4-4	MMSZ4706T1	5.2-24, 5.2-31	MMUN2113LT1	5.1-12
MMSF6N01Z	5.4-4, 5.4-9	MMSZ4707T1	5.2-24, 5.2-31	MMUN2114LT1	5.1-12
MMSZ2V4T1	5.2-24, 5.2-32	MMSZ4708T1	5.2-24, 5.2-31	MMUN2115LT1	5.1-12
MMSZ2V7T1	5.2-24, 5.2-32	MMSZ4709T1	5.2-24, 5.2-31	MMUN2116LT1	5.1-12
MMSZ3V0T1	5.2-24, 5.2-32	MMSZ4710T1	5.2-24, 5.2-31	MMUN2130LT1	5.1-12
MMSZ3V3T1	5.2-24, 5.2-32	MMSZ4711T1	5.2-24, 5.2-31	MMUN2131LT1	5.1-12
MMSZ3V6T1	5.2-24, 5.2-32	MMSZ4712T1	5.2-25, 5.2-31	MMUN2132LT1	5.1-12
MMSZ3V9T1	5.2-24, 5.2-32	MMSZ4713T1	5.2-25, 5.2-31	MMUN2133LT1	5.1-12
MMSZ4V3T1	5.2-24, 5.2-32	MMSZ4714T1	5.2-25, 5.2-31	MMUN2134LT1	5.1-12
MMSZ4V7T1	5.2-24, 5.2-32	MMSZ4715T1	5.2-25, 5.2-31	MMUN2211LT1	5.1-12
MMSZ5V1T1	5.2-24, 5.2-32	MMSZ4716T1	5.2-25, 5.2-31	MMUN2212LT1	5.1-12
MMSZ5V6T1	5.2-24, 5.2-32	MMSZ4717T1	5.2-25, 5.2-31	MMUN2213LT1	5.1-12
MMSZ6V2T1	5.2-24, 5.2-32	MMSZ5221BT1	5.2-24, 5.2-29	MMUN2214LT1	5.1-12
MMSZ6V8T1	5.2-24, 5.2-32	MMSZ5222BT1	5.2-24, 5.2-29	MMUN2215LT1	5.1-12
MMSZ7V5T1	5.2-24, 5.2-32	MMSZ5223BT1	5.2-24, 5.2-29	MMUN2216LT1	5.1-12
MMSZ8V2T1	5.2-24, 5.2-32	MMSZ5224BT1	5.2-24, 5.2-29	MMUN2230LT1	5.1-12
MMSZ9V1T1	5.2-24, 5.2-32	MMSZ5225BT1	5.2-24, 5.2-29	MMUN2231LT1	5.1-12
MMSZ10T1	5.2-24, 5.2-32	MMSZ5226BT1	5.2-24, 5.2-29	MMUN2232LT1	5.1-12
MMSZ11T1	5.2-24, 5.2-32	MMSZ5227BT1	5.2-24, 5.2-29	MMUN2233LT1	5.1-12
MMSZ12T1	5.2-24, 5.2-32	MMSZ5228BT1	5.2-24, 5.2-29	MMUN2234LT1	5.1-12
MMSZ13T1	5.2-24, 5.2-32	MMSZ5229BT1	5.2-24, 5.2-29	MOC2A60-5	5.8-10
MMSZ15T1	5.2-24, 5.2-32	MMSZ5230BT1	5.2-24, 5.2-29	MOC2A60-10	5.8-10
MMSZ16T1	5.2-24, 5.2-32	MMSZ5231BT1	5.2-24, 5.2-30	MOC2R60-10	5.8-10
MMSZ18T1	5.2-24, 5.2-32	MMSZ5232BT1	5.2-24, 5.2-30	MOC2R60-15	5.8-10
MMSZ20T1	5.2-24, 5.2-32	MMSZ5233BT1	5.2-24, 5.2-30	MOC119	5.8-9
MMSZ22T1	5.2-24, 5.2-32	MMSZ5234BT1	5.2-24, 5.2-30	MOC205	5.8-9
MMSZ24T1	5.2-24, 5.2-32	MMSZ5235BT1	5.2-24, 5.2-30	MOC205R2	5.8-9
MMSZ27T1	5.2-24, 5.2-33	MMSZ5236BT1	5.2-24, 5.2-30	MOC206	5.8-9
MMSZ30T1	5.2-25, 5.2-33	MMSZ5237BT1	5.2-24, 5.2-30	MOC206R2	5.8-9
MMSZ33T1	5.2-25, 5.2-33	MMSZ5238BT1	5.2-24, 5.2-30	MOC207	5.8-9
MMSZ36T1	5.2-25, 5.2-33	MMSZ5239BT1	5.2-24, 5.2-30	MOC207R2	5.8-9
MMSZ39T1	5.2-25, 5.2-33	MMSZ5240BT1	5.2-24, 5.2-30	MOC211	5.8-9
MMSZ43T1	5.2-25, 5.2-33	MMSZ5241BT1	5.2-24, 5.2-30	MOC211R2	5.8-9
MMSZ47T1	5.2-25, 5.2-33	MMSZ5242BT1	5.2-24, 5.2-30	MOC212	5.8-9
MMSZ51T1	5.2-25, 5.2-33	MMSZ5243BT1	5.2-24, 5.2-30	MOC212R2	5.8-9
MMSZ56T1	5.2-25, 5.2-33	MMSZ5244BT1	5.2-24, 5.2-30	MOC213	5.8-9
MMSZ62T1	5.2-25, 5.2-33	MMSZ5245BT1	5.2-24, 5.2-30	MOC213R2	5.8-9
MMSZ68T1	5.2-25, 5.2-33	MMSZ5246BT1	5.2-24, 5.2-30	MOC215	5.8-9
MMSZ75T1	5.2-25, 5.2-33	MMSZ5247BT1	5.2-24, 5.2-30	MOC215R2	5.8-9
MMSZ4678T1	5.2-24, 5.2-31	MMSZ5248BT1	5.2-24, 5.2-30	MOC216	5.8-9
MMSZ4679T1	5.2-24, 5.2-31	MMSZ5249BT1	5.2-24, 5.2-30	MOC216R2	5.8-9
MMSZ4680T1	5.2-24, 5.2-31	MMSZ5250BT1	5.2-24, 5.2-30	MOC217	5.8-9
MMSZ4681T1	5.2-24, 5.2-31	MMSZ5251BT1	5.2-24, 5.2-30	MOC217R2	5.8-9
MMSZ4682T1	5.2-24, 5.2-31	MMSZ5252BT1	5.2-24, 5.2-30	MOC223	5.8-9
MMSZ4683T1	5.2-24, 5.2-31	MMSZ5253BT1	5.2-24, 5.2-30	MOC223R2	5.8-9
MMSZ4684T1	5.2-24, 5.2-31	MMSZ5254BT1	5.2-24, 5.2-30	MOC256	5.8-9
MMSZ4685T1	5.2-24, 5.2-31	MMSZ5255BT1	5.2-25, 5.2-30	MOC256R2	5.8-9
MMSZ4686T1	5.2-24, 5.2-31	MMSZ5256BT1	5.2-25, 5.2-30	MOC3010	5.8-8
MMSZ4687T1	5.2-24, 5.2-31	MMSZ5257BT1	5.2-25, 5.2-30	MOC3011	5.8-8
MMSZ4688T1	5.2-24, 5.2-31	MMSZ5258BT1	5.2-25, 5.2-30	MOC3012	5.8-8
MMSZ4689T1	5.2-24, 5.2-31	MMSZ5259BT1	5.2-25, 5.2-30	MOC3021	5.8-8

# Device Index

Device Index	Page	Device Index	Page	Device Index	Page
MOC3022	5.8-8	MPC947	3.1-16	MPS750	5.1-4
MOC3023	5.8-8	MPC948	3.1-16	MPS751	5.1-4
MOC3031	5.8-8	MPC949	3.1-17	MPS911	5.10-17, 5.10-21
MOC3032	5.8-8	MPC950	3.1-17	MPS918	5.1-6
MOC3033	5.8-8	MPC951	3.1-17	MPS2222A	5.1-2
MOC3041	5.8-8	MPC952	3.1-17	MPS2369A	5.1-6
MOC3042	5.8-8	MPC956	3.1-17	MPS2907A	5.1-2
MOC3043	5.8-8	MPC970	3.1-17	MPS3563	5.1-6
MOC3051	5.8-8	MPC974	3.1-16	MPS3646	5.1-6
MOC3052	5.8-8	MPC980	3.1-17	MPS3866	5.1-6
MOC3061	5.8-8	MPC992	3.1-17	MPS3904	5.1-3
MOC3062	5.8-8	MPC2104P	2.8-6	MPS3906	5.1-3
MOC3063	5.8-8	MPC2105A	2.8-6	MPS4250	5.1-3
MOC3063S	5.8-3	MPC2105P	2.8-6	MPS4258	5.1-6
MOC3063SR2V	5.8-3	MPC2106A	2.8-6	MPS5179	5.1-6
MOC3063SV	5.8-3	MPC2604GA	2.8-3	MPS6428	5.1-3
MOC3063TV	5.8-3	MPC2605	2.8-3	MPS6521	5.1-3
MOC3063V	5.8-3	MPC9159-410	3.1-17	MPS6523	5.1-3
MOC3081	5.8-8	MPF102	5.1-20	MPS6595	5.1-6
MOC3082	5.8-8	MPF910	5.1-22	MPS6602	5.1-2
MOC3083	5.8-8	MPF930	5.1-22	MPS6652	5.1-2
MOC3162	5.8-8	MPF960	5.1-22	MPS6715	5.1-4
MOC3163	5.8-8	MPF970	5.1-21	MPS6717	5.1-3
MOC5007	5.8-8	MPF971	5.1-21	MPS6727	5.1-4
MOC5008	5.8-8	MPF990	5.1-22	MPS8099	5.1-2
MOC5009	5.8-8	MPF3821	5.1-20	MPS8599	5.1-2
MOC8020	5.8-7	MPF4392	5.1-21	MPSA05	5.1-2
MOC8021	5.8-7	MPF4393	5.1-21	MPSA06	5.1-2
MOC8030	5.8-7	MPF4856	5.1-21	MPSA13	5.1-4
MOC8050	5.8-7	MPF4857	5.1-21	MPSA14	5.1-4
MOC8080	5.8-7	MPF4859	5.1-21	MPSA16	5.1-7
MOC8100	5.8-6	MPF4860	5.1-21	MPSA17	5.1-7
MOC8107	5.8-6	MPF4861	5.1-21	MPSA18	5.1-3
MOC8108	5.8-6	MPF6659	5.1-22	MPSA20	5.1-2
MOC8111	5.8-6	MPF6660	5.1-22	MPSA27	5.1-4
MOC8112	5.8-6	MPF6661	5.1-22	MPSA29	5.1-4
MOC8113	5.8-6	MPN3404	5.1-35, 5.1-36	MPSA42	5.1-5
MOC8204	5.8-7	MPN3700	5.1-35, 5.1-36	MPSA44	5.1-5
MOC207	5.8-9	MPQ2222A	5.1-9	MPSA55	5.1-2
MOC207R2	5.8-9	MPQ2369	5.1-9	MPSA56	5.1-2
MOC208	5.8-9	MPQ2483	5.1-9	MPSA63	5.1-4
MOC208R2	5.8-9	MPQ2484	5.1-9	MPSA64	5.1-4
MOC211	5.8-9	MPQ2907A	5.1-9	MPSA70	5.1-2
MOC211R2	5.8-9	MPQ3467	5.1-9	MPSA75	5.1-4
MOC213	5.8-9	MPQ3725	5.1-9	MPSA77	5.1-4
MOC213R2	5.8-9	MPQ3762	5.1-9	MPSA92	5.1-5
MOC217	5.8-9	MPQ3798	5.1-9	MPSH07A	5.1-6
MOC217R2	5.8-9	MPQ3799	5.1-9	MPSH10	5.1-6
MOC223	5.8-9	MPQ3904	5.1-9	MPSH11	5.1-6
MOC223R2	5.8-9	MPQ3906	5.1-9	MPSH17	5.1-6
MPA1000	3.1-6, 3.1-7	MPQ6001	5.1-9	MPSH20	5.1-6
MPA1016	3.1-5, 3.1-22	MPQ6002	5.1-9	MPSH24	5.1-6
MPA1036	3.1-5, 3.1-6, 3.1-22	MPQ6100A	5.1-9	MPSH69	5.1-6
MPA1064	3.1-5, 3.1-6, 3.1-22	MPQ6426	5.1-9	MPSH81	5.1-6
MPA1100	3.1-5, 3.1-6, 3.1-22	MPQ6501	5.1-9	MPSW01A	5.1-4
MPA1765	3.1-11, 3.1-36	MPQ6502	5.1-9	MPSW06	5.1-3
MPA17000	3.1-11	MPQ6600A1	5.1-9	MPSW42	5.1-5
MPA17128	3.1-11, 3.1-36	MPQ6700	5.1-9	MPSW45A	5.1-4
MPC27T415	2.8-3	MPQ6842	5.1-9	MPSW51A	5.1-4
MPC27T416	2.8-3	MPQ7042	5.1-9	MPSW56	5.1-3
MPC903	3.1-16	MPQ7043	5.1-9	MPSW64	5.1-4
MPC904	3.1-16	MPQ7051	5.1-9	MPSW92	5.1-5
MPC905	3.1-16	MPQ7093	5.1-9	MPX10D	5.9-7, 5.9-8
MPC911	3.1-17	MPS404A	5.1-7	MPX10DP	5.9-8
MPC930	3.1-17	MPS571	5.10-17, 5.10-21	MPX10GP	5.9-8
MPC931	3.1-17	MPS650	5.1-4	MPX10GS	5.9-8
MPC946	3.1-17	MPS651	5.1-4	MPX10GSX	5.9-8

# Device Index

Device Index	Page	Device Index	Page	Device Index	Page
MPX10GVP	5.9-8	MPX2200ASX	5.9-8	MPX5999D	5.9-7, 5.9-9
MPX50D	5.9-7, 5.9-8	MPX2200D	5.9-8	MPX7050D	5.9-7, 5.9-9
MPX50DP	5.9-8	MPX2200DP	5.9-8	MPX7050DP	5.9-9
MPX50GP	5.9-8	MPX2200GP	5.9-8	MPX7050GP	5.9-9
MPX50GS	5.9-8	MPX2200GSX	5.9-8	MPX7050GS	5.9-9
MPX50GSX	5.9-8	MPX2300DT1	5.9-7	MPX7050GSX	5.9-9
MPX50GVP	5.9-8	MPX2700A	5.9-7, 5.9-8	MPX7100A	5.9-7, 5.9-9
MPX50GVSX	5.9-8	MPX2700AP	5.9-8	MPX7100AP	5.9-9
MPX100A	5.9-7, 5.9-8	MPX2700AS	5.9-8	MPX7100AS	5.9-9
MPX100AP	5.9-8	MPX2700ASX	5.9-8	MPX7100D	5.9-7, 5.9-9
MPX100AS	5.9-8	MPX2700D	5.9-7, 5.9-8	MPX7100DP	5.9-9
MPX100ASX	5.9-8	MPX2700DP	5.9-8	MPX7100GP	5.9-9
MPX100D	5.9-7, 5.9-8	MPX2700GP	5.9-8	MPX7100GS	5.9-9
MPX100DP	5.9-8	MPX2700GSX	5.9-8	MPX7100GSX	5.9-9
MPX100GP	5.9-8	MPX4100A	5.9-7, 5.9-9	MPX7100GVP	5.9-9
MPX100GS	5.9-8	MPX4100AP	5.9-9	MPX7100GVSX	5.9-9
MPX100GSX	5.9-8	MPX4100AS	5.9-9	MPX7200A	5.9-7, 5.9-9
MPX100GVP	5.9-8	MPX4100ASX	5.9-9	MPX7200AP	5.9-9
MPX100GVS	5.9-8	MPX4101A	5.9-7, 5.9-9	MPX7200D	5.9-7, 5.9-9
MPX100GVSX	5.9-8	MPX4101AP	5.9-9	MPX7200DP	5.9-9
MPX200A	5.9-7, 5.9-8	MPX4101AS	5.9-9	MPX7200GP	5.9-9
MPX200AP	5.9-8	MPX4101ASX	5.9-9	MPXB5050G	5.9-10
MPX200AS	5.9-8	MPX4115A	5.9-7, 5.9-9	MPXL5010	5.9-10
MPX200D	5.9-7, 5.9-8	MPX4115AP	5.9-9	MPXS4100A	5.9-10
MPX200DP	5.9-8	MPX4115AS	5.9-9	MPXS4115A	5.9-10
MPX200GP	5.9-8	MPX4115ASX	5.9-9	MPXT2010G	5.9-10
MPX200GS	5.9-8	MPX4250A	5.9-7, 5.9-9	MPXT4105	5.9-10
MPX200GSX	5.9-8	MPX4250AP	5.9-9	MPXT5006	5.9-10
MPX200GVP	5.9-8	MPX4250ASX	5.9-9	MR754	5.6-13
MPX700A	5.9-7, 5.9-8	MPX5010D	5.9-7, 5.9-9	MR760	5.6-13
MPX700AP	5.9-8	MPX5010DP	5.9-9	MR852	5.6-13
MPX700ASX	5.9-8	MPX5010GP	5.9-9	MR856	5.6-13
MPX700D	5.9-7, 5.9-8	MPX5010GS	5.9-9	MR2504	5.6-13
MPX700DP	5.9-8	MPX5010GSX	5.9-9	MR2510	5.6-13
MPX700GP	5.9-8	MPX5010GVP	5.9-9	MR2535L	5.2-18, 5.6-3, 5.6-13
MPX700GSX	5.9-8	MPX5010GVS	5.9-9	MR2535S	5.6-3, 5.6-13
MPX906D	5.9-8	MPX5010GVSX	5.9-9	MRA0510-50H	5.10-12
MPX906GVW	5.9-8	MPX5050D	5.9-7, 5.9-9	MRA1000-3.5L	5.10-12
MPX2010D	5.9-7, 5.9-8	MPX5050DP	5.9-9	MRA1000-7L	5.10-12
MPX2010DP	5.9-8	MPX5050GP	5.9-9	MRA1000-14L	5.10-12
MPX2010GP	5.9-8	MPX5050GS	5.9-9	MRA1600-002	5.10-10
MPX2010GS	5.9-8	MPX5050GSX	5.9-9	MRA4003	5.6-13
MPX2010GSX	5.9-8	MPX5050GVP	5.9-9	MRA4004	5.6-13
MPX2010GVP	5.9-8	MPX5050GVS	5.9-9	MRA4005	5.6-13
MPX2010GVS	5.9-8	MPX5050GVSX	5.9-9	MRA4006	5.6-13
MPX2050D	5.9-7, 5.9-8	MPX5100A	5.9-7, 5.9-9	MRA4007	5.6-13
MPX2050DP	5.9-8	MPX5100AP	5.9-9	MRA4935T3	5.6-13
MPX2050GP	5.9-8	MPX5100AS	5.9-9	MRA4936T3	5.6-13
MPX2050GSX	5.9-8	MPX5100ASX	5.9-9	MRA4937T3	5.6-13
MPX2050GVP	5.9-8	MPX5100D	5.9-4, 5.9-7, 5.9-9	MRF134	5.10-4
MPX2052D	5.9-7	MPX5100DP	5.9-9	MRF136	5.10-4
MPX2100	5.9-4	MPX5100GP	5.9-9	MRF136Y	5.10-4
MPX2100A	5.9-7, 5.9-8	MPX5100GS	5.9-9	MRF137	5.10-4
MPX2100AP	5.9-8	MPX5100GSX	5.9-9	MRF140	5.10-4
MPX2100AS	5.9-8	MPX5100GVP	5.9-9	MRF141	5.10-4
MPX2100ASX	5.9-8	MPX5100GVS	5.9-9	MRF141G	5.10-4
MPX2100D	5.9-8	MPX5100GVSX	5.9-9	MRF148	5.10-4
MPX2100DP	5.9-8	MPX5500D	5.9-7, 5.9-9	MRF150	5.10-4
MPX2100GP	5.9-8	MPX5500DP	5.9-9	MRF151	5.10-4
MPX2100GS	5.9-8	MPX5500GP	5.9-9	MRF151G	5.10-4
MPX2100GSX	5.9-8	MPX5500GS	5.9-9	MRF154	5.10-4
MPX2100GVP	5.9-8	MPX5500GSX	5.9-9	MRF157	5.10-4
MPX2100GVS	5.9-8	MPX5700D	5.9-7, 5.9-9	MRF158	5.10-5
MPX2100GVSX	5.9-8	MPX5700DP	5.9-9	MRF160	5.10-5
MPX2200A	5.9-7, 5.9-8	MPX5700GP	5.9-9	MRF166C	5.10-5
MPX2200AP	5.9-8	MPX5700GS	5.9-9	MRF173	5.10-4
MPX2200AS	5.9-8	MPX5700GSX	5.9-9	MRF173CQ	5.10-4

# Device Index

Device Index	Page	Device Index	Page	Device Index	Page
MRF174	5.10-4	MRF553	5.10-8, 5.10-18	MRF2947AT1	5.10-19
MRF175GU	5.10-5	MRF555	5.10-9, 5.10-18	MRF2947RA	5.10-21
MRF175GV	5.10-4	MRF557	5.10-9, 5.10-18	MRF2947RAT1	5.10-19
MRF175LU	5.10-5	MRF559	5.10-9, 5.10-18	MRF3010	5.10-6
MRF175LV	5.10-4	MRF571	5.10-18, 5.10-21	MRF3866R2	5.10-19
MRF176GU	5.10-5	MRF577T1	5.10-19, 5.10-21	MRF4427	5.10-8, 5.10-19
MRF176GV	5.10-4	MRF581	5.10-9, 5.10-18, 5.10-21, 5.10-22	MRF5003	5.10-5
MRF177	5.10-5	MRF581A	5.10-18, 5.10-22	MRF5007	5.10-5
MRF181S	5.10-6	MRF587	5.10-20, 5.10-22	MRF5015	5.10-5
MRF181Z	5.10-6	MRF641	5.10-9	MRF5035	5.10-5
MRF182	5.10-6	MRF644	5.10-9	MRF5211LT1	5.10-19, 5.10-21
MRF182S	5.10-6	MRF650	5.10-9	MRF5711LT1	5.10-19, 5.10-21
MRF183	5.10-6	MRF652	5.10-9	MRF5811LT1	5.10-19, 5.10-21
MRF183S	5.10-6	MRF652S	5.10-9	MRF5812	5.10-19, 5.10-21, 5.10-22
MRF184	5.10-6	MRF653	5.10-9	MRF5943	5.10-19, 5.10-22
MRF184S	5.10-6	MRF653S	5.10-9	MRF6401	5.10-13
MRF185	5.10-6	MRF654	5.10-9	MRF6402	5.10-13
MRF186	5.10-6	MRF658	5.10-9	MRF6404	5.10-13
MRF190S	5.10-5	MRF837	5.10-9, 5.10-18	MRF6408	5.10-13
MRF191	5.10-5	MRF840	5.10-9	MRF6409	5.10-10
MRF191S	5.10-5	MRF842	5.10-9	MRF6414	5.10-10
MRF192	5.10-5	MRF847	5.10-9	MRF6522-5	5.10-6
MRF192S	5.10-5	MRF857S	5.10-12	MRF6522-10	5.10-6
MRF193	5.10-5	MRF858	5.10-12	MRF6525-5	5.10-13
MRF194	5.10-5	MRF858S	5.10-12	MRF6525-10	5.10-13
MRF195S	5.10-6	MRF859	5.10-12	MRF8372	5.10-9
MRF196	5.10-6	MRF859S	5.10-12	MRF8372R1	5.10-19
MRF196S	5.10-6	MRF861	5.10-12	MRF9011LT1	5.10-19, 5.10-21
MRF197	5.10-6	MRF862	5.10-12	MRF9242T1	5.10-15
MRF197S	5.10-6	MRF891	5.10-10	MRF9251T1	5.10-15
MRF198	5.10-6	MRF891S	5.10-10	MRF9282T1	5.10-15
MRF199	5.10-6	MRF892	5.10-10	MRF9331LT1	5.10-19
MRF224	5.10-8	MRF894	5.10-10	MRF9411BLT1	5.10-19, 5.10-21
MRF240	5.10-8	MRF896	5.10-10	MRF9411LT1	5.10-19, 5.10-21
MRF247	5.10-8	MRF897	5.10-10	MRF9511ALT1	5.10-19, 5.10-21
MRF255	5.10-4	MRF897R	5.10-10	MRF9511LT1	5.10-19, 5.10-21
MRF275G	5.10-5	MRF898	5.10-10	MRF9742	5.10-15
MRF275L	5.10-5	MRF899	5.10-10	MRF9745T1	5.10-15
MRF280S	5.10-13	MRF901	5.10-18, 5.10-21	MRF9762	5.10-15
MRF280Z	5.10-13	MRF917T1	5.10-19, 5.10-21	MRF9811T1	5.10-15
MRF281S	5.10-13	MRF927T1	5.10-19, 5.10-21	MRF9822T1	5.10-15
MRF281Z	5.10-13	MRF947AT1	5.10-19, 5.10-21	MRF10005	5.10-11
MRF282S	5.10-13	MRF947BT1	5.10-19, 5.10-21	MRF10031	5.10-11
MRF284	5.10-13	MRF947RT3	5.10-19, 5.10-21	MRF10070	5.10-11
MRF284S	5.10-13	MRF947T1	5.10-19, 5.10-21	MRF10120	5.10-11
MRF286	5.10-13	MRF951	5.10-18, 5.10-21	MRF10150	5.10-11
MRF286S	5.10-13	MRF957T1	5.10-19, 5.10-21	MRF10350	5.10-11
MRF313	5.10-8	MRF1000MA	5.10-10	MRF10500	5.10-11
MRF314	5.10-7	MRF1000MB	5.10-10	MRF10501	5.10-11
MRF316	5.10-7	MRF1002MA	5.10-10	MRF15030	5.10-13
MRF317	5.10-7	MRF1002MB	5.10-10	MRF15060	5.10-13
MRF321	5.10-8	MRF1004MA	5.10-10	MRF15060S	5.10-13
MRF323	5.10-8	MRF1004MB	5.10-10	MRF15090	5.10-13
MRF325	5.10-8	MRF1015MA	5.10-11	MRF16006	5.10-10
MRF326	5.10-8	MRF1015MB	5.10-11	MRF16030	5.10-10
MRF327	5.10-8	MRF1035MA	5.10-11	MRF20030	5.10-13
MRF329	5.10-8	MRF1035MB	5.10-11	MRF20060	5.10-13
MRF392	5.10-8	MRF1090MA	5.10-11	MRF20060S	5.10-13
MRF393	5.10-8	MRF1090MB	5.10-11	MRF20120	5.10-13
MRF421	5.10-7	MRF1150MA	5.10-11	MRF2600	5.10-35
MRF422	5.10-7	MRF1150MB	5.10-11	MRF2602	5.10-35
MRF426	5.10-7	MRF1507	5.10-5	MRF2604	5.10-35
MRF429	5.10-7	MRF1946	5.10-8	MRFA2600	5.10-35
MRF448	5.10-7	MRF1946A	5.10-8	MRFA2602	5.10-35
MRF454	5.10-7	MRF2628	5.10-8	MRFA2604	5.10-35
MRF455	5.10-7	MRF2947A	5.10-21	MRFIC0001	5.10-25
MRF492	5.10-7			MRFIC0903	5.10-24
				MRFIC0904	5.10-26
				MRFIC0910	5.10-26

# Device Index

<u>Device Index</u>	<u>Page</u>	<u>Device Index</u>	<u>Page</u>	<u>Device Index</u>	<u>Page</u>
MRFC0912	5.10-26	MTB20N20E	5.4-11	MTP3N120E	5.4-13
MRFC0913	5.10-27	MTB23P06E	5.4-19	MTP4N40E	5.4-13
MRFC0914	5.10-27	MTB23P06V	5.4-6	MTP4N50E	5.4-13
MRFC0915	5.10-24, 5.10-25	MTB30N06EL	5.4-11	MTP4N80E	5.4-13
MRFC0916	5.10-24, 5.10-25	MTB30N06VL	5.4-6, 5.4-21	MTP5N40E	5.4-13
MRFC0917	5.10-27	MTB30P06V	5.4-6	MTP5P06V	5.4-6, 5.4-19
MRFC0920	5.10-27	MTB33N10E	5.4-11	MTP6N60E	5.4-13
MRFC0923	5.10-26	MTB36N06V	5.4-6, 5.4-11	MTP6P20E	5.4-19
MRFC0931	5.10-26	MTB50N06V	5.4-6, 5.4-11	MTP7N20E	5.4-13
MRFC1501	5.10-24	MTB50N06VL	5.4-6, 5.4-11, 5.4-21	MTP8N50E	5.4-13
MRFC1502	5.10-24	MTB50P03HDL	5.4-3, 5.4-19, 5.4-21	MTP9N25E	5.4-13
MRFC1801	5.10-24			MTP10N10E	5.4-13
MRFC1803	5.10-27, 5.10-28	MTB52N06V	5.4-6	MTP10N10EL	5.4-13, 5.4-21
MRFC1804	5.10-25	MTB52N06VL	5.4-6	MTP10N40E	5.4-13
MRFC1805	5.10-27	MTB60N06HD	5.4-3, 5.4-11	MTP12N10E	5.4-13
MRFC1806	5.10-27	MTB75N03HDL	5.4-3, 5.4-11, 5.4-21	MTP12P10	5.4-19
MRFC1807	5.10-27, 5.10-28	MTB75N05HD	5.4-3, 5.4-11	MTP15N05EL	5.4-14, 5.4-21
MRFC1808	5.10-24	MTB75N06HD	5.4-3, 5.4-11	MTP15N06V	5.4-5, 5.4-14
MRFC1813	5.10-27, 5.10-28	MTD1N50E	5.4-10	MTP15N06VL	5.4-5, 5.4-14, 5.4-21
MRFC1814	5.10-25	MTD1N60E	5.4-10	MTP16N25E	5.4-13
MRFC1817	5.10-27	MTD1N80E	5.4-10	MTP20N06V	5.4-5, 5.4-14
MRFC1818	5.10-27	MTD1P50E	5.4-18	MTP20N20E	5.4-13
MRFC2001	5.10-24	MTD2N40E	5.4-10	MTP23P06V	5.4-6, 5.4-19
MRFC2002	5.10-26	MTD2N50E	5.4-10	MTP27N10E	5.4-13
MRFC2003	5.10-24	MTD3N25E	5.4-10	MTP30N06EL	5.4-21
MRFC2004	5.10-26	MTD4N20E	5.4-10	MTP30N06VL	5.4-5, 5.4-14, 5.4-21
MRFC2006	5.10-26	MTD5N10E	5.4-10	MTP30P06V	5.4-6
MRFC2101	5.10-26	MTD5N25E	5.4-10	MTP33N10E	5.4-13
MRFC2401	5.10-25	MTD5P06E	5.4-18	MTP36N06V	5.4-5, 5.4-14
MRFC2403	5.10-28	MTD5P06V	5.4-6, 5.4-18	MTP50N05EL	5.4-21
MRFC2404	5.10-28	MTD6N10E	5.4-10	MTP50N06EL	5.4-21
MRFC2406	5.10-28	MTD6N15	5.4-10	MTP50N06V	5.4-5, 5.4-14
MRFC2410	5.10-28	MTD6N20E	5.4-10	MTP50N06VL	5.4-5, 5.4-14, 5.4-21
MRFC09021	5.10-24	MTD6P10E	5.4-18	MTP50P03HDL	5.4-3, 5.4-19, 5.4-21
MSA1022-BT1	5.1-14	MTD8N60E	5.4-10		
MSA1022-CT1	5.1-14	MTD9N10E	5.4-10	MTP52N06V	5.4-5, 5.4-14
MSB81T1	5.1-14	MTD10N05E	5.4-10	MTP52N06VL	5.4-5, 5.4-14, 5.4-21
MSB709-RT1	5.1-11	MTD10N10EL	5.4-10, 5.4-20	MTP60N06HD	5.4-3, 5.4-14
MSB709-ST1	5.1-11	MTD15N06V	5.4-5, 5.4-10, 5.4-20	MTP75N03HDL	5.4-3, 5.4-14, 5.4-21
MSB710-QT1	5.1-11	MTD15N06VL	5.4-5		
MSB710-RT1	5.1-11	MTD20N03HDL	5.4-3, 5.4-10, 5.4-20	MTP75N05HD	5.4-3, 5.4-14
MSB1218A-RT1	5.1-11			MTP75N06HD	5.4-3, 5.4-14
MSC1621T1	5.1-14	MTD20N06HD	5.4-3, 5.4-10	MTP2955V	5.4-6, 5.4-19
MSC2295-BT1	5.1-14	MTD20N06HDL	5.4-3, 5.4-10, 5.4-20	MTP3055EL	5.4-21
MSC2295-CT1	5.1-14			MTP3055V	5.4-5, 5.4-14
MSC2404-CT1	5.1-14	MTD20N06V	5.4-5	MTP3055VL	5.4-5, 5.4-14, 5.4-21
MSC3130T1	5.1-14	MTD20P03HDL	5.4-3, 5.4-18, 5.4-20	MTSF1P02HD	5.4-4, 5.4-17
MSC3930-BT1	5.1-11			MTSF3N03HD	5.4-4, 5.4-9
MSD601-RT1	5.1-11	MTD20P06HDL	5.4-3, 5.4-18, 5.4-20	MTV6N100E	5.4-12
MSD601-ST1	5.1-11			MTV10N100E	5.4-12
MSD602-RT1	5.1-11	MTD30P06V	5.4-19	MTV16N50E	5.4-12
MSD1010T1	5.1-16, 5.1-41	MTD2955V	5.4-6	MTV20N50E	5.4-12
MSD1328-RT1	5.1-11	MTD3055V	5.4-5, 5.4-10	MTV25N50E	5.4-12
MSD1819A-RT1	5.1-11	MTD3055VL	5.4-5, 5.4-10, 5.4-20	MTV32N05E	5.4-12
MTB1N100E	5.4-11	MTDF1N02HD	5.4-4, 5.4-9	MTV32N20E	5.4-12
MTB2P50E	5.4-19	MTDF1N03HD	5.4-4, 5.4-9	MTW6N100E	5.4-15
MTB3N100E	5.4-11	MTP1N50E	5.4-13	MTW7N80E	5.4-15
MTB3N120E	5.4-11	MTP1N60E	5.4-13	MTW8N60E	5.4-15
MTB4N80E	5.4-11	MTP1N100E	5.4-13	MTW10N100E	5.4-15
MTB6N60E	5.4-11	MTP2N40E	5.4-13	MTW14N50E	5.4-15
MTB8N50E	5.4-11	MTP2N50E	5.4-13	MTW16N40E	5.4-15
MTB9N25E	5.4-11	MTP2N60E	5.4-13	MTW20N50E	5.4-15
MTB10N40E	5.4-11	MTP2P50E	5.4-19	MTW24N40E	5.4-15
MTB15N06V	5.4-6, 5.4-11	MTP3N25E	5.4-13	MTW32N20E	5.4-15
MTB15N06VL	5.4-6	MTP3N50E	5.4-13	MTW32N25E	5.4-15
MTB16N25E	5.4-11	MTP3N60E	5.4-13	MTW35N15E	5.4-15
MTB20N06V	5.4-6	MTP3N100E	5.4-13	MTW45N10E	5.4-15



# Device Index

Device Index	Page	Device Index	Page	Device Index	Page
MTY20N50E	5.4-16	MUN5232T1	5.1-13	MV1403	5.1-31, 5.1-32
MTY25N60E	5.4-16	MUN5233DW1T1	5.1-13	MV1404	5.1-31, 5.1-32
MTY30N50E	5.4-16	MUN5233T1	5.1-13	MV1405	5.1-31, 5.1-32
MTY55N20E	5.4-16	MUN5234DW1T1	5.1-13	MV1620	5.1-25, 5.1-27
MTY100N10E	5.4-16	MUN5234T1	5.1-13	MV1624	5.1-27
MUN2111T1	5.1-12	MUN5235DW1T1	5.1-13	MV1626	5.1-27
MUN2112T1	5.1-12	MUN5311DW1T1	5.1-13	MV1628	5.1-25, 5.1-27
MUN2113T1	5.1-12	MUN5312DW1T1	5.1-13	MV1630	5.1-27
MUN2114T1	5.1-12	MUN5313DW1T1	5.1-13	MV1634	5.1-27
MUN2115T1	5.1-12	MUN5314DW1T1	5.1-13	MV1636	5.1-27
MUN2116T1	5.1-12	MUN5315DW1T1	5.1-13	MV1638	5.1-25, 5.1-27
MUN2130T1	5.1-12	MUN5316DW1T1	5.1-13	MV1640	5.1-27
MUN2131T1	5.1-12	MUN5330DW1T1	5.1-13	MV1642	5.1-25, 5.1-27
MUN2132T1	5.1-12	MUN5331DW1T1	5.1-13	MV1644	5.1-27
MUN2133T1	5.1-12	MUN5332DW1T1	5.1-13	MV1648	5.1-27
MUN2134T1	5.1-12	MUN5333DW1T1	5.1-13	MV1650	5.1-25, 5.1-27
MUN2211T1	5.1-12	MUN5334DW1T1	5.1-13	MV2101	5.1-25, 5.1-27
MUN2212T1	5.1-12	MUR120	5.6-10	MV2103	5.1-27
MUN2213T1	5.1-12	MUR160	5.6-10	MV2104	5.1-27
MUN2214T1	5.1-12	MUR420	5.6-10	MV2105	5.1-25, 5.1-27
MUN2215T1	5.1-12	MUR460	5.6-10	MV2107	5.1-27
MUN2216T1	5.1-12	MUR620CT	5.6-11	MV2108	5.1-27
MUN2230T1	5.1-12	MUR820	5.6-11	MV2109	5.1-25, 5.1-27
MUN2231T1	5.1-12	MUR840	5.6-11	MV2111	5.1-27
MUN2232T1	5.1-12	MUR860	5.6-11	MV2113	5.1-27
MUN2233T1	5.1-12	MUR880E	5.6-3, 5.6-11	MV2114	5.1-27
MUN2234T1	5.1-12	MUR1100E	5.6-10	MV2115	5.1-25, 5.1-27
MUN5111DW1T1	5.1-13	MUR1520	5.6-11	MV7005T1	5.1-30, 5.1-32
MUN5111T1	5.1-13	MUR1540	5.6-11	MV7404T1	5.1-31, 5.1-32
MUN5112DW1T1	5.1-13	MUR1560	5.6-11	MVAM108	5.1-30, 5.1-32
MUN5112T1	5.1-13	MUR1620CT	5.6-11	MVAM109	5.1-30, 5.1-32
MUN5113DW1T1	5.1-13	MUR1620CTR	5.6-11	MVAM115	5.1-31, 5.1-32
MUN5113T1	5.1-13	MUR1640CT	5.6-11	MVAM125	5.1-31, 5.1-32
MUN5114DW1T1	5.1-13	MUR1660CT	5.6-11	MXR9745T1	5.10-15
MUN5114T1	5.1-13	MUR3020PT	5.6-12	MZ4099	5.2-19
MUN5115DW1T1	5.1-13	MUR3020WT	5.6-12	MZ4101	5.2-19
MUN5115T1	5.1-13	MUR3040	5.6-12	MZ4104	5.2-19
MUN5116DW1T1	5.1-13	MUR3040PT	5.6-12	MZ4614	5.2-19
MUN5116T1	5.1-13	MUR3040WT	5.6-12	MZ4615	5.2-19
MUN5130DW1T1	5.1-13	MUR3060PT	5.6-12	MZ4616	5.2-19
MUN5130T1	5.1-13	MUR3060WT	5.6-12	MZ4617	5.2-19
MUN5131DW1T1	5.1-13	MUR3080	5.6-12	MZ4618	5.2-19
MUN5131T1	5.1-13	MUR4100E	5.6-10	MZ4619	5.2-19
MUN5132DW1T1	5.1-13	MUR6040	5.6-12	MZ4620	5.2-19
MUN5132T1	5.1-13	MUR8100E	5.6-11	MZ4622	5.2-19
MUN5133DW1T1	5.1-13	MUR10120E	5.6-3, 5.6-11	MZ4623	5.2-19
MUN5133T1	5.1-13	MUR10150E	5.6-3, 5.6-11	MZ4624	5.2-19
MUN5134DW1T1	5.1-13	MURB1620CT	5.6-10	MZ4625	5.2-19
MUN5134T1	5.1-13	MURB1660CT	5.6-10	MZ4626	5.2-19
MUN5135DW1T1	5.1-13	MURD320	5.6-10	MZ4627	5.2-19
MUN5211DW1T1	5.1-13	MURD620CT	5.6-10	MZ5520B	5.2-19
MUN5211T1	5.1-13	MURF820	5.6-11	MZ5521B	5.2-19
MUN5212DW1T1	5.1-13	MURF1620CT	5.6-11	MZ5523B	5.2-19
MUN5212T1	5.1-13	MURF1660CT	5.6-11	MZ5524B	5.2-19
MUN5213DW1T1	5.1-13	MURH840CT	5.6-3, 5.6-11	MZ5525B	5.2-19
MUN5213T1	5.1-13	MURH860CT	5.6-3, 5.6-11	MZ5527B	5.2-19
MUN5214DW1T1	5.1-13	MURHB840CT	5.6-3, 5.6-10	MZ5529B	5.2-19
MUN5214T1	5.1-13	MURP20020CT	5.6-12	MZP4728A	5.2-21
MUN5215DW1T1	5.1-13	MURP20040CT	5.6-12	MZP4729A	5.2-21
MUN5215T1	5.1-13	MURS120T3	5.6-10	MZP4734A	5.2-21
MUN5216DW1T1	5.1-13	MURS160T3	5.6-10	MZP4735A	5.2-21
MUN5216T1	5.1-13	MURS320T3	5.6-10	MZP4737A	5.2-21
MUN5230DW1T1	5.1-13	MURS360T3	5.6-10	MZP4738A	5.2-21
MUN5230T1	5.1-13	MV104	5.1-25, 5.1-28	MZP4740A	5.2-21
MUN5231DW1T1	5.1-13	MV104G	5.1-25	MZP4741A	5.2-21
MUN5231T1	5.1-13	MV209	5.1-29, 5.1-31	MZP4744A	5.2-21
MUN5232DW1T1	5.1-13	MV409	5.1-30, 5.1-31	MZP4745A	5.2-21

# Device Index

Device Index	Page	Device Index	Page	Device Index	Page
MZP4746A	5.2-21	P6KE120CA	5.2-4	PC68HC11G0	2.6-7
MZP4749A	5.2-21	P6KE130A	5.2-5	PC68HC11G5	2.6-7
MZP4750A	5.2-21	P6KE150A	5.2-5	PC68HC11G7	2.6-7
MZP4751A	5.2-21	P6KE150CA	5.2-5	PC68HC11J6	2.6-7
MZP4752A	5.2-21	P6KE160A	5.2-5	PC68HC711D3	2.6-8
MZP4753A	5.2-21	P6KE160CA	5.2-5	PC68HC711E9	2.6-8
NE556D	4.10-2	P6KE180A	5.2-5	PC68HC711E20	2.6-8
NE556N	4.10-2	P6KE180CA	5.2-5	PC68HC711G5	2.6-8
P2N2222A	5.1-7	P6KE200A	5.2-5	PC68HC711J6	2.6-8
P2N2907A	5.1-7	P6KE200CA	5.2-5	PC68HC711K4	2.6-8
P6KE6.8A	5.2-4	P6SMB6.8AT3	5.2-15	PC68HC711D3	2.6-8
P6KE6.8CA	5.2-4	P6SMB7.5AT3	5.2-15	PC68HC711M2	2.6-8
P6KE7.5A	5.2-4	P6SMB9.1AT3	5.2-15	PC68HC711N4	2.6-8
P6KE7.5CA	5.2-4	P6SMB10AT3	5.2-15	PZT651T1	5.1-17
P6KE8.2A	5.2-4	P6SMB12AT3	5.2-15	PZT751T1	5.1-17
P6KE8.2CA	5.2-4	P6SMB12CAT3	5.2-15	PZT2222AT1	5.1-17
P6KE9.1A	5.2-4	P6SMB13AT3	5.2-15	PZT2907AT1	5.1-17
P6KE9.1CA	5.2-4	P6SMB13CAT3	5.2-15	PZTA14T1	5.1-17
P6KE10A	5.2-4	P6SMB15AT3	5.2-15	PZTA42T1	5.1-17
P6KE10CA	5.2-4	P6SMB15CAT3	5.2-15	PZTA64T1	5.1-17
P6KE11A	5.2-4	P6SMB16AT3	5.2-15	PZTA92T1	5.1-17
P6KE11CA	5.2-4	P6SMB16CAT3	5.2-15	PZTA96T1	5.1-17
P6KE12A	5.2-4	P6SMB18AT3	5.2-15	RFA8090B	5.10-35
P6KE12CA	5.2-4	P6SMB18CAT3	5.2-15	SA5.0A	5.2-2
P6KE13A	5.2-4	P6SMB20AT3	5.2-15	SA5.0CA	5.2-2
P6KE13CA	5.2-4	P6SMB20CAT3	5.2-15	SA6.0A	5.2-2
P6KE15A	5.2-4	P6SMB22AT3	5.2-15	SA6.0CA	5.2-2
P6KE15CA	5.2-4	P6SMB22CAT3	5.2-15	SA7.0A	5.2-2
P6KE16A	5.2-4	P6SMB24AT3	5.2-15	SA7.0CA	5.2-2
P6KE16CA	5.2-4	P6SMB24CAT3	5.2-15	SA8.0A	5.2-2
P6KE18A	5.2-4	P6SMB27AT3	5.2-15	SA8.0CA	5.2-2
P6KE18CA	5.2-4	P6SMB27CAT3	5.2-15	SA11A	5.2-2
P6KE20A	5.2-4	P6SMB30AT3	5.2-15	SA11CA	5.2-2
P6KE20CA	5.2-4	P6SMB30CAT3	5.2-15	SA12A	5.2-2
P6KE22A	5.2-4	P6SMB33AT3	5.2-15	SA12CA	5.2-2
P6KE22CA	5.2-4	P6SMB33CAT3	5.2-15	SA13A	5.2-2
P6KE24A	5.2-4	P6SMB36AT3	5.2-15	SA13CA	5.2-2
P6KE24CA	5.2-4	P6SMB36CAT3	5.2-15	SA14A	5.2-2
P6KE27A	5.2-4	P6SMB39AT3	5.2-15	SA14CA	5.2-2
P6KE27CA	5.2-4	P6SMB39CAT3	5.2-15	SA15A	5.2-2
P6KE30A	5.2-4	P6SMB47AT3	5.2-15	SA15CA	5.2-2
P6KE30CA	5.2-4	P6SMB47CAT3	5.2-15	SA16A	5.2-2
P6KE33A	5.2-4	P6SMB51AT3	5.2-15	SA16CA	5.2-2
P6KE33CA	5.2-4	P6SMB51CAT3	5.2-15	SA17A	5.2-2
P6KE36A	5.2-4	P6SMB56AT3	5.2-15	SA17CA	5.2-2
P6KE36CA	5.2-4	P6SMB56CAT3	5.2-15	SA20A	5.2-3
P6KE39A	5.2-4	P6SMB62AT3	5.2-15	SA20CA	5.2-3
P6KE39CA	5.2-4	P6SMB62CAT3	5.2-15	SA24A	5.2-3
P6KE43A	5.2-4	P6SMB68AT3	5.2-15	SA24CA	5.2-3
P6KE43CA	5.2-4	P6SMB68CAT3	5.2-15	SA26A	5.2-3
P6KE47A	5.2-4	P6SMB82AT3	5.2-15	SA26CA	5.2-3
P6KE47CA	5.2-4	P6SMB82CAT3	5.2-15	SA28A	5.2-3
P6KE51A	5.2-4	P6SMB91AT3	5.2-15	SA28CA	5.2-3
P6KE51CA	5.2-4	P6SMB91CAT3	5.2-15	SA30A	5.2-3
P6KE56A	5.2-4	P6SMB100AT3	5.2-15	SA30CA	5.2-3
P6KE56CA	5.2-4	P6SMB110AT3	5.2-15	SA36A	5.2-3
P6KE62A	5.2-4	P6SMB120AT3	5.2-15	SA36CA	5.2-3
P6KE62CA	5.2-4	P6SMB150AT3	5.2-15	SA51A	5.2-3
P6KE68A	5.2-4	P6SMB160AT3	5.2-15	SA51CA	5.2-3
P6KE68CA	5.2-4	P6SMB170AT3	5.2-15	SA58A	5.2-3
P6KE75A	5.2-4	P6SMB180AT3	5.2-15	SA58CA	5.2-3
P6KE75CA	5.2-4	P6SMB200AT3	5.2-15	SA60A	5.2-3
P6KE82A	5.2-4	PBF259	5.1-7	SA60CA	5.2-3
P6KE82CA	5.2-4	PBF259S	5.1-7	SA75A	5.2-3
P6KE91A	5.2-4	PBF493	5.1-7	SA75CA	5.2-3
P6KE91CA	5.2-4	PBF493S	5.1-7	SA78A	5.2-3
P6KE120A	5.2-4	PC68F333	2.6-21	SA78CA	5.2-3

# Device Index

<b>Device Index</b>	<b>Page</b>	<b>Device Index</b>	<b>Page</b>	<b>Device Index</b>	<b>Page</b>
SA90A	5.2-3	SN54LS126A	3.1-16	SN54LS353	3.1-32
SA90CA	5.2-3	SN54LS132	3.1-36	SN54LS365A	3.1-14
SA110A	5.2-3	SN54LS133	3.1-25	SN54LS366A	3.1-14
SA110CA	5.2-3	SN54LS137	3.1-20	SN54LS367A	3.1-14
SA130A	5.2-3	SN54LS138	3.1-20	SN54LS368A	3.1-14
SA130CA	5.2-3	SN54LS139	3.1-21	SN54LS373	3.1-30
SA160A	5.2-3	SN54LS145	3.1-20	SN54LS374	3.1-24
SA160CA	5.2-3	SN54LS147	3.1-21	SN54LS375	3.1-30
SA170A	5.2-3	SN54LS148	3.1-22	SN54LS377	3.1-24
SA170CA	5.2-3	SN54LS151	3.1-31	SN54LS378	3.1-23
SAA1042	4.3-9	SN54LS153	3.1-32	SN54LS379	3.1-22
SAA1042V	4.3-9	SN54LS155	3.1-20	SN54LS386	3.1-27
SG3525A	4.2-15	SN54LS156	3.1-20	SN54LS390	3.1-19
SG3526	4.2-15	SN54LS157	3.1-32	SN54LS393	3.1-19
SL5501	5.8-6	SN54LS158	3.1-32	SN54LS398	3.1-33
SN54LS00	3.1-26	SN54LS160A	3.1-18	SN54LS399	3.1-33
SN54LS01	3.1-26	SN54LS161A	3.1-18	SN54LS490	3.1-19
SN54LS02	3.1-28	SN54LS162A	3.1-18	SN54LS540	3.1-15
SN54LS03	3.1-26	SN54LS163A	3.1-18	SN54LS541	3.1-15
SN54LS04	3.1-29	SN54LS164	3.1-37	SN54LS569A	3.1-18
SN54LS05	3.1-29	SN54LS165	3.1-37	SN54LS623	3.1-15
SN54LS08	3.1-25	SN54LS166	3.1-37	SN54LS640	3.1-15
SN54LS09	3.1-25	SN54LS168	3.1-19	SN54LS641	3.1-38
SN54LS10	3.1-26	SN54LS169	3.1-19	SN54LS642	3.1-38
SN54LS11	3.1-26	SN54LS170	3.1-36	SN54LS645	3.1-15
SN54LS12	3.1-26	SN54LS173A	3.1-22	SN54LS669	3.1-20
SN54LS13	3.1-36	SN54LS174	3.1-23	SN54LS670	3.1-36
SN54LS14	3.1-36	SN54LS175	3.1-25	SN54LS682	3.1-18
SN54LS15	3.1-26	SN54LS181	3.1-13	SN54LS684	3.1-18
SN54LS20	3.1-25	SN54LS190	3.1-19	SN54LS688	3.1-18
SN54LS21	3.1-25	SN54LS191	3.1-19	SN54LS748	3.1-22
SN54LS22	3.1-25	SN54LS192	3.1-19	SN54LS795	3.1-14
SN54LS26	3.1-25	SN54LS193	3.1-19	SN54LS796	3.1-14
SN54LS27	3.1-28	SN54LS194A	3.1-37	SN54LS797	3.1-14
SN54LS28	3.1-28	SN54LS195A	3.1-38	SN54LS798	3.1-14
SN54LS30	3.1-25	SN54LS196	3.1-18	SN54LS848	3.1-22
SN54LS32	3.1-28	SN54LS197	3.1-18	SN74LS00	3.1-26
SN54LS33	3.1-28	SN54LS221	3.1-33	SN74LS01	3.1-26
SN54LS37	3.1-25	SN54LS240	3.1-15	SN74LS02	3.1-28
SN54LS38	3.1-26	SN54LS241	3.1-15	SN74LS03	3.1-26
SN54LS40	3.1-25	SN54LS242	3.1-16	SN74LS04	3.1-29
SN54LS42	3.1-20	SN54LS243	3.1-16	SN74LS05	3.1-29
SN54LS47	3.1-21	SN54LS244	3.1-15	SN74LS08	3.1-25
SN54LS48	3.1-21	SN54LS245	3.1-15	SN74LS09	3.1-25
SN54LS51	3.1-27	SN54LS247	3.1-21	SN74LS10	3.1-26
SN54LS54	3.1-26	SN54LS248	3.1-21	SN74LS11	3.1-26
SN54LS55	3.1-26	SN54LS249	3.1-21	SN74LS12	3.1-26
SN54LS73A	3.1-23	SN54LS251	3.1-31	SN74LS13	3.1-36
SN54LS74A	3.1-23	SN54LS253	3.1-32	SN74LS14	3.1-36
SN54LS75	3.1-30	SN54LS256	3.1-30	SN74LS15	3.1-26
SN54LS76A	3.1-23	SN54LS257B	3.1-32	SN74LS20	3.1-25
SN54LS77	3.1-30	SN54LS258B	3.1-33	SN74LS21	3.1-25
SN54LS83A	3.1-13	SN54LS259	3.1-30	SN74LS22	3.1-25
SN54LS85	3.1-17	SN54LS260	3.1-28	SN74LS26	3.1-25
SN54LS86	3.1-27	SN54LS266	3.1-27	SN74LS27	3.1-28
SN54LS90	3.1-19	SN54LS273	3.1-24	SN74LS28	3.1-28
SN54LS92	3.1-19	SN54LS279	3.1-31	SN74LS30	3.1-25
SN54LS93	3.1-18	SN54LS280	3.1-34	SN74LS32	3.1-28
SN54LS95B	3.1-37	SN54LS283	3.1-13	SN74LS33	3.1-28
SN54LS107A	3.1-23	SN54LS290	3.1-19	SN74LS37	3.1-25
SN54LS109A	3.1-23	SN54LS293	3.1-18	SN74LS38	3.1-26
SN54LS112A	3.1-23	SN54LS298	3.1-32	SN74LS40	3.1-25
SN54LS113A	3.1-23	SN54LS299	3.1-37	SN74LS42	3.1-20
SN54LS114A	3.1-23	SN54LS322A	3.1-37	SN74LS47	3.1-21
SN54LS122	3.1-33	SN54LS323	3.1-37	SN74LS48	3.1-21
SN54LS123	3.1-33	SN54LS348	3.1-22	SN74LS51	3.1-27
SN54LS125A	3.1-16	SN54LS352	3.1-32	SN74LS54	3.1-26

# Device Index

Device Index	Page	Device Index	Page	Device Index	Page
SN74LS55	3.1-26	SN74LS248	3.1-21	T2500DFP	5.7-9
SN74LS73A	3.1-23	SN74LS249	3.1-21	T2500M	5.7-8
SN74LS74A	3.1-23	SN74LS251	3.1-31	T2500MFP	5.7-9
SN74LS75	3.1-30	SN74LS253	3.1-32	T2500N	5.7-8
SN74LS76A	3.1-23	SN74LS257B	3.1-32	T2500NFP	5.7-9
SN74LS77	3.1-30	SN74LS258B	3.1-33	T2800B	5.7-10
SN74LS83A	3.1-13	SN74LS259	3.1-30	T2800D	5.7-10
SN74LS85	3.1-17	SN74LS260	3.1-28	T2800M	5.7-10
SN74LS86	3.1-27	SN74LS266	3.1-27	TCA0372	4.1-4
SN74LS90	3.1-19	SN74LS273	3.1-24	TCA3385	4.7-35
SN74LS92	3.1-19	SN74LS279	3.1-31	TCA3388	4.7-35
SN74LS93	3.1-18	SN74LS280	3.1-34	TCA3388DP	4.7-24
SN74LS95B	3.1-37	SN74LS283	3.1-13	TCA3388FP	4.7-24
SN74LS107A	3.1-23	SN74LS290	3.1-19	TCF5600	4.2-23
SN74LS109A	3.1-23	SN74LS293	3.1-18	TCF6000	4.9-3
SN74LS112A	3.1-23	SN74LS298	3.1-32	TDA1085C	4.3-10
SN74LS113A	3.1-23	SN74LS299	3.1-37	TDA1085CD	4.3-10
SN74LS114A	3.1-23	SN74LS322A	3.1-37	TIL111	5.8-6
SN74LS122	3.1-33	SN74LS323	3.1-37	TIL113	5.8-7
SN74LS123	3.1-33	SN74LS348	3.1-22	TIL117	5.8-6
SN74LS125A	3.1-16	SN74LS352	3.1-32	TIP29C	5.5-3
SN74LS126A	3.1-16	SN74LS353	3.1-32	TIP30C	5.5-3
SN74LS132	3.1-36	SN74LS365A	3.1-14	TIP31C	5.5-3
SN74LS133	3.1-25	SN74LS366A	3.1-14	TIP32C	5.5-3
SN74LS136	3.1-27	SN74LS367A	3.1-14	TIP33C	5.5-6
SN74LS137	3.1-20	SN74LS368A	3.1-14	TIP34C	5.5-6
SN74LS138	3.1-20	SN74LS373	3.1-30	TIP35A	5.5-7
SN74LS139	3.1-21	SN74LS374	3.1-24	TIP35C	5.5-7
SN74LS145	3.1-20	SN74LS375	3.1-30	TIP36A	5.5-7
SN74LS147	3.1-21	SN74LS377	3.1-24	TIP36C	5.5-7
SN74LS148	3.1-22	SN74LS378	3.1-23	TIP41C	5.5-4
SN74LS151	3.1-31	SN74LS379	3.1-22	TIP42C	5.5-4
SN74LS153	3.1-32	SN74LS386	3.1-27	TIP47	5.5-3
SN74LS155	3.1-20	SN74LS390	3.1-19	TIP48	5.5-3
SN74LS156	3.1-20	SN74LS393	3.1-19	TIP49	5.5-3
SN74LS157	3.1-32	SN74LS395	3.1-37	TIP50	5.5-3
SN74LS158	3.1-32	SN74LS398	3.1-33	TIP102	5.5-5
SN74LS160A	3.1-18	SN74LS399	3.1-33	TIP107	5.5-5
SN74LS161A	3.1-18	SN74LS490	3.1-19	TIP112	5.5-3
SN74LS162A	3.1-18	SN74LS540	3.1-15	TIP117	5.5-3
SN74LS163A	3.1-18	SN74LS541	3.1-15	TIP122	5.5-4
SN74LS164	3.1-37	SN74LS569A	3.1-18	TIP127	5.5-4
SN74LS165	3.1-37	SN74LS623	3.1-15	TIP140	5.5-6
SN74LS166	3.1-37	SN74LS640	3.1-15	TIP141	5.5-6
SN74LS168	3.1-19	SN74LS641	3.1-38	TIP142	5.5-6
SN74LS169	3.1-19	SN74LS642	3.1-38	TIP145	5.5-6
SN74LS170	3.1-36	SN74LS645	3.1-15	TIP146	5.5-6
SN74LS173A	3.1-22	SN74LS669	3.1-20	TIP147	5.5-6
SN74LS174	3.1-23	SN74LS670	3.1-36	TIP2955	5.5-7
SN74LS175	3.1-25	SN74LS682	3.1-18	TIP3055	5.5-7
SN74LS181	3.1-13	SN74LS684	3.1-18	TL062AC	4.1-3
SN74LS190	3.1-19	SN74LS688	3.1-18	TL062C	4.1-3
SN74LS191	3.1-19	SN74LS748	3.1-22	TL062V	4.1-3
SN74LS192	3.1-19	SN74LS795	3.1-14	TL064AC	4.1-4
SN74LS193	3.1-19	SN74LS796	3.1-14	TL064C	4.1-4
SN74LS194A	3.1-37	SN74LS797	3.1-14	TL064V	4.1-5
SN74LS195A	3.1-38	SN74LS798	3.1-14	TL071AC	4.1-2
SN74LS196	3.1-18	SN74LS848	3.1-22	TL071C	4.1-2
SN74LS197	3.1-18	T2322B	5.7-7	TL072AC	4.1-3
SN74LS221	3.1-33	T2322D	5.7-7	TL072C	4.1-3
SN74LS240	3.1-15	T2322M	5.7-7	TL074AC	4.1-4
SN74LS241	3.1-15	T2323B	5.7-8	TL074C	4.1-4
SN74LS242	3.1-16	T2323D	5.7-8	TL081AC	4.1-2
SN74LS243	3.1-16	T2323M	5.7-8	TL081C	4.1-2
SN74LS244	3.1-15	T2500B	5.7-8	TL082AC	4.1-3
SN74LS245	3.1-15	T2500BFP	5.7-9	TL082C	4.1-3
SN74LS247	3.1-21	T2500D	5.7-8	TL084AC	4.1-4

# Device Index

<u>Device Index</u>	<u>Page</u>	<u>Device Index</u>	<u>Page</u>	<u>Device Index</u>	<u>Page</u>
TL084C	4.1-4	XC68HC05D32	2.5-6, 2.6-23	XC56007FJ50	2.1-5
TL431AC	4.4-2	XC68HC05F2	2.6-23	XC56007FJ66	2.1-5
TL431AI	4.4-2	XC68HC05F6	2.6-23	XC56009PV80	2.1-5
TL431BC	4.4-2	XC68HC05F8	2.6-23	XC56156FE60	2.1-2
TL431BI	4.4-2	XC68HC05G9	2.6-23	XC56156FV40	2.1-2
TL431C	4.4-2	XC68HC05G10	2.6-23	XC56156FV50	2.1-2
TL431I	4.4-2	XC68HC05H2	2.6-23	XC56166FV60	2.1-2
TL494	4.2-15	XC68HC05I8	2.6-23	XC68334	2.6-21
TL594	4.2-15	XC68HC05J3	2.6-23	XC96002RC33	2.1-17
TL780-XXC	4.2-3	XC68HC05K0	2.6-23	XC96002RC40	2.1-17
TP3007S	5.10-10	XC68HC05K1	2.6-23	XCP56002PV80	2.1-5
TP3008	5.10-10	XC68HC05L1	2.6-24	XMMAS40GWB	5.9-12
TP3021	5.10-10	XC68HC05L2	2.6-24	μA78S40	4.2-14
TP3034	5.10-10	XC68HC05L4	2.6-24	1.5KE6.8A	5.2-7
TP3069	5.10-10	XC68HC05L11	2.6-24	1.5KE6.8CA	5.2-7
TP5002S	5.10-9	XC68HC05M4	2.6-24	1.5KE7.5A	5.2-7
TP5015	5.10-9	XC68HC05P3	2.6-24	1.5KE7.5CA	5.2-7
TP5051	5.10-9	XC68HC05P18	2.5-7	1.5KE8.2A	5.2-7
TPV596A	5.10-12	XC68HC05RC16	2.5-8	1.5KE8.2CA	5.2-7
TPV597	5.10-12	XC68HC05SC11	2.6-24	1.5KE10A	5.2-7
TPV598	5.10-12	XC68HC05SC21	2.6-24	1.5KE10CA	5.2-7
TPV695A	5.10-13	XC68HC05SC24	2.6-24	1.5KE11A	5.2-7
TPV6030	5.10-13	XC68HC05SC27	2.6-24	1.5KE11CA	5.2-7
TPV7025	5.10-13	XC68HC05SC28	2.5-8	1.5KE12A	5.2-7
TPV8100B	5.10-13	XC68HC05T2	2.5-8, 2.6-24	1.5KE12CA	5.2-7
UAA1016B	4.3-3	XC68HC05T3	2.6-24	1.5KE13A	5.2-7
UAA1041	4.9-9	XC68HC05T4	2.6-24	1.5KE13CA	5.2-7
UAA1041B	4.9-3, 4.9-9	XC68HC05T12	2.6-24	1.5KE15A	5.2-7
UAA2016	4.3-3	XC68HC05X4	2.6-24	1.5KE15CA	5.2-7
UAA2016D	4.3-3	XC68HC05X16	2.6-24	1.5KE16A	5.2-7
UAA2016P	4.3-3	XC68HC11C0	2.6-6	1.5KE16CA	5.2-7
UC2842A	4.2-12	XC68HC11E20	2.6-6	1.5KE18A	5.2-7
UC2842B	4.2-13	XC68HC11N4	2.6-8	1.5KE18CA	5.2-7
UC2843A	4.2-12	XC68HC11P2	2.6-8	1.5KE20A	5.2-7
UC2843B	4.2-13	XC68HC705B32	2.5-9	1.5KE20CA	5.2-7
UC2844	4.2-12	XC68HC705C	2.6-23	1.5KE22A	5.2-7
UC2844B	4.2-13	XC68HC705C5	2.6-23	1.5KE22CA	5.2-7
UC2845	4.2-12	XC68HC705D9	2.5-9	1.5KE24A	5.2-7
UC2845B	4.2-13	XC68HC705F6	2.5-9	1.5KE24CA	5.2-7
UC3842A	4.2-12	XC68HC705F8	2.6-23	1.5KE27A	5.2-7
UC3842B	4.2-12	XC68HC705G9	2.6-23	1.5KE27CA	5.2-7
UC3842BV	4.2-12	XC68HC705G10	2.6-23	1.5KE30A	5.2-7
UC3843A	4.2-12	XC68HC705I8	2.6-23	1.5KE30CA	5.2-7
UC3843B	4.2-13	XC68HC705J3	2.6-23	1.5KE33A	5.2-7
UC3843BV	4.2-13	XC68HC705K1	2.6-23	1.5KE33CA	5.2-7
UC3844	4.2-12	XC68HC705L1	2.5-10, 2.6-24	1.5KE36A	5.2-7
UC3844B	4.2-13	XC68HC705L2	2.6-24	1.5KE36CA	5.2-7
UC3844BV	4.2-13	XC68HC705L4	2.6-24	1.5KE39A	5.2-7
UC3845	4.2-12	XC68HC705P9	2.6-24	1.5KE39CA	5.2-7
UC3845B	4.2-13	XC68HC705T10	2.6-24	1.5KE43A	5.2-7
UC3845BV	4.2-13	XC68HC705T12	2.6-24	1.5KE43CA	5.2-7
ULN2003A	4.6-8	XC68HC705V8	2.5-10	1.5KE47A	5.2-7
ULN2004A	4.6-8	XC68HC705X4	2.5-10, 2.6-24	1.5KE47CA	5.2-7
ULN2803	4.6-8	XC68HC711P2	2.6-8	1.5KE51A	5.2-7
ULN2804	4.6-8	XC68HC916X1	2.6-18	1.5KE51CA	5.2-7
VN10LM	5.1-22	XC68HC916Y1	2.6-18	1.5KE56A	5.2-7
VN0300L	5.1-22	XC56001AFC27	2.1-5	1.5KE56CA	5.2-7
VN0610LL	5.1-22	XC56001AFC33	2.1-5	1.5KE62A	5.2-7
VN1706L	5.1-22	XC56001AFE27	2.1-5	1.5KE62CA	5.2-7
VN2222LL	5.1-22	XC56001AFE33	2.1-5	1.5KE68A	5.2-7
VN2406L	5.1-22	XC56001ARC27	2.1-5	1.5KE68CA	5.2-7
VN2410L	5.1-22	XC56001ARC33	2.1-5	1.5KE75A	5.2-7
XC56L002PV40	2.1-5	XC56002PV40	2.1-5	1.5KE75CA	5.2-7
XC56L007FJ40	2.1-5	XC56002PV66	2.1-5	1.5KE82A	5.2-7
XC56L811BU40	2.1-3	XC56004FJ50	2.1-5	1.5KE82CA	5.2-7
XC56L812BU40	2.1-3	XC56004FJ66	2.1-5	1.5KE91A	5.2-7
XC68HC05C4	2.6-23	XC56005PV50	2.1-5	1.5KE91CA	5.2-7

# Device Index

Device Index	Page	Device Index	Page	Device Index	Page
1.5KE100A	5.2-7	1N4687	5.2-19	1N5148A	5.1-25
1.5KE100CA	5.2-7	1N4688	5.2-19	1N5221B	5.2-19
1.5KE110A	5.2-7	1N4689	5.2-19	1N5222B	5.2-19
1.5KE110CA	5.2-7	1N4690	5.2-19	1N5223B	5.2-19
1.5KE120A	5.2-7	1N4691	5.2-19	1N5224B	5.2-19
1.5KE120CA	5.2-7	1N4692	5.2-19	1N5225B	5.2-19
1.5KE130A	5.2-7	1N4693	5.2-19	1N5226B	5.2-19
1.5KE130CA	5.2-7	1N4694	5.2-19	1N5227B	5.2-19
1.5KE150A	5.2-8	1N4695	5.2-19	1N5228B	5.2-19
1.5KE150CA	5.2-8	1N4696	5.2-19	1N5229B	5.2-19
1.5KE160A	5.2-8	1N4697	5.2-19	1N5230B	5.2-19
1.5KE160CA	5.2-8	1N4698	5.2-19	1N5231B	5.2-19
1.5KE170A	5.2-8	1N4699	5.2-19	1N5232B	5.2-19
1.5KE170CA	5.2-8	1N4700	5.2-19	1N5233B	5.2-19
1.5KE180A	5.2-8	1N4702	5.2-19	1N5234B	5.2-19
1.5KE180CA	5.2-8	1N4703	5.2-19	1N5235B	5.2-19
1.5KE200A	5.2-8	1N4704	5.2-19	1N5236B	5.2-19
1.5KE200CA	5.2-8	1N4705	5.2-19	1N5237B	5.2-19
1.5KE220A	5.2-8	1N4707	5.2-20	1N5238B	5.2-19
1.5KE220CA	5.2-8	1N4708	5.2-20	1N5239B	5.2-19
1.5KE250A	5.2-8	1N4728A	5.2-21	1N5240B	5.2-19
1.5KE250CA	5.2-8	1N4729A	5.2-21	1N5241B	5.2-19
1.5SMC6.8AT3	5.2-17	1N4730A	5.2-21	1N5242B	5.2-19
1.5SMC8.2AT3	5.2-17	1N4731A	5.2-21	1N5243B	5.2-19
1.5SMC9.1AT3	5.2-17	1N4732A	5.2-21	1N5244B	5.2-19
1.5SMC10AT3	5.2-17	1N4733A	5.2-21	1N5245B	5.2-19
1.5SMC11AT3	5.2-17	1N4734A	5.2-21	1N5246B	5.2-19
1.5SMC12AT3	5.2-17	1N4735A	5.2-21	1N5247B	5.2-19
1.5SMC13AT3	5.2-17	1N4736A	5.2-21	1N5248B	5.2-19
1.5SMC15AT3	5.2-17	1N4737A	5.2-21	1N5249B	5.2-20
1.5SMC18AT3	5.2-17	1N4738A	5.2-21	1N5250B	5.2-20
1.5SMC22AT3	5.2-17	1N4739A	5.2-21	1N5251B	5.2-20
1.5SMC24AT3	5.2-17	1N4740A	5.2-21	1N5252B	5.2-20
1.5SMC27AT3	5.2-17	1N4741A	5.2-21	1N5253B	5.2-20
1.5SMC30AT3	5.2-17	1N4742A	5.2-21	1N5254B	5.2-20
1.5SMC33AT3	5.2-17	1N4743A	5.2-21	1N5255B	5.2-20
1.5SMC36AT3	5.2-17	1N4744A	5.2-21	1N5256B	5.2-20
1.5SMC39AT3	5.2-17	1N4745A	5.2-21	1N5257B	5.2-20
1.5SMC43AT3	5.2-17	1N4746A	5.2-21	1N5258B	5.2-20
1.5SMC47AT3	5.2-17	1N4747A	5.2-21	1N5259B	5.2-20
1.5SMC51AT3	5.2-17	1N4748A	5.2-21	1N5260B	5.2-20
1.5SMC56AT3	5.2-17	1N4749A	5.2-21	1N5261B	5.2-20
1.5SMC62AT3	5.2-17	1N4750A	5.2-21	1N5262B	5.2-20
1.5SMC68AT3	5.2-17	1N4751A	5.2-21	1N5263B	5.2-20
1.5SMC75AT3	5.2-17	1N4752A	5.2-21	1N5264B	5.2-20
1.5SMC82AT3	5.2-17	1N4753A	5.2-21	1N5265B	5.2-20
1.5SMC91AT3	5.2-17	1N4754A	5.2-21	1N5266B	5.2-20
1N821	5.2-34	1N4755A	5.2-21	1N5267B	5.2-20
1N821A	5.2-34	1N4756A	5.2-21	1N5268B	5.2-20
1N823	5.2-34	1N4757A	5.2-21	1N5269B	5.2-20
1N823A	5.2-34	1N4758A	5.2-21	1N5270B	5.2-20
1N825	5.2-34	1N4759A	5.2-21	1N5271B	5.2-20
1N825A	5.2-34	1N4760A	5.2-21	1N5272B	5.2-20
1N827	5.2-34	1N4761A	5.2-22	1N5273B	5.2-20
1N827A	5.2-34	1N4762A	5.2-22	1N5274B	5.2-20
1N829	5.2-34	1N4763A	5.2-22	1N5275B	5.2-20
1N829A	5.2-34	1N4764A	5.2-22	1N5276B	5.2-20
1N4004	5.6-13	1N4935	5.6-13	1N5278B	5.2-20
1N4007	5.6-13	1N4937	5.6-13	1N5279B	5.2-20
1N4678	5.2-19	1N5139	5.1-26	1N5280B	5.2-20
1N4679	5.2-19	1N5140	5.1-25, 5.1-26	1N5281B	5.2-20
1N4681	5.2-19	1N5140A	5.1-25	1N5283	5.2-34
1N4682	5.2-19	1N5143	5.1-26	1N5287	5.2-34
1N4683	5.2-19	1N5144	5.1-25, 5.1-26	1N5297	5.2-34
1N4684	5.2-19	1N5144A	5.1-25	1N5298	5.2-34
1N4685	5.2-19	1N5145	5.1-26	1N5305	5.2-34
1N4686	5.2-19	1N5148	5.1-25, 5.1-26	1N5309	5.2-34

# Device Index

<u>Device Index</u>	<u>Page</u>	<u>Device Index</u>	<u>Page</u>	<u>Device Index</u>	<u>Page</u>
1N5310	5.2-34	1N5448A	5.1-26	1N6267A	5.2-7
1N5311	5.2-34	1N5449A	5.1-26	1N6268A	5.2-7
1N5312	5.2-34	1N5450A	5.1-25, 5.1-26	1N6269A	5.2-7
1N5313	5.2-34	1N5451A	5.1-26	1N6271A	5.2-7
1N5314	5.2-34	1N5452A	5.1-25, 5.1-26	1N6272A	5.2-7
1N5333B	5.2-21	1N5453A	5.1-26	1N6273A	5.2-7
1N5334B	5.2-21	1N5455A	5.1-26	1N6274A	5.2-7
1N5335B	5.2-21	1N5456A	5.1-25, 5.1-26	1N6275A	5.2-7
1N5336B	5.2-21	1N5817	5.6-6	1N6276A	5.2-7
1N5337B	5.2-21	1N5818	5.6-6	1N6277A	5.2-7
1N5338B	5.2-21	1N5819	5.6-6	1N6278A	5.2-7
1N5339B	5.2-21	1N5820	5.6-6	1N6279A	5.2-7
1N5340B	5.2-21	1N5821	5.6-6	1N6280A	5.2-7
1N5341B	5.2-21	1N5822	5.6-6	1N6281A	5.2-7
1N5342B	5.2-21	1N5908	5.2-6	1N6282A	5.2-7
1N5343B	5.2-21	1N5913B	5.2-21	1N6283A	5.2-7
1N5344B	5.2-21	1N5914B	5.2-21	1N6284A	5.2-7
1N5345B	5.2-21	1N5916B	5.2-21	1N6285A	5.2-7
1N5346B	5.2-21	1N5917B	5.2-21	1N6286A	5.2-7
1N5347B	5.2-21	1N5918B	5.2-21	1N6287A	5.2-7
1N5348B	5.2-21	1N5919B	5.2-21	1N6288A	5.2-7
1N5349B	5.2-21	1N5920B	5.2-21	1N6289A	5.2-7
1N5350B	5.2-21	1N5921B	5.2-21	1N6290A	5.2-7
1N5351B	5.2-21	1N5922B	5.2-21	1N6291A	5.2-7
1N5352B	5.2-21	1N5923B	5.2-21	1N6292A	5.2-7
1N5353B	5.2-21	1N5924B	5.2-21	1N6293A	5.2-7
1N5354B	5.2-21	1N5925B	5.2-21	1N6294A	5.2-7
1N5355B	5.2-21	1N5926B	5.2-21	1N6295A	5.2-7
1N5356B	5.2-21	1N5927B	5.2-21	1N6296A	5.2-7
1N5357B	5.2-21	1N5929B	5.2-21	1N6297A	5.2-7
1N5358B	5.2-21	1N5930B	5.2-21	1N6298A	5.2-7
1N5359B	5.2-21	1N5931B	5.2-21	1N6299A	5.2-8
1N5360B	5.2-21	1N5932B	5.2-21	1N6300A	5.2-8
1N5361B	5.2-21	1N5933B	5.2-21	1N6301A	5.2-8
1N5362B	5.2-21	1N5934B	5.2-21	1N6302A	5.2-8
1N5363B	5.2-21	1N5935B	5.2-21	1N6303A	5.2-8
1N5364B	5.2-21	1N5936B	5.2-21	1SMA5.0AT3	5.2-11
1N5365B	5.2-21	1N5937B	5.2-21	1SMA6.0AT3	5.2-11
1N5366B	5.2-21	1N5938B	5.2-21	1SMA6.5AT3	5.2-11
1N5367B	5.2-21	1N5939B	5.2-21	1SMA7.0AT3	5.2-11
1N5368B	5.2-21	1N5941B	5.2-21	1SMA7.5AT3	5.2-11
1N5369B	5.2-21	1N5943B	5.2-21	1SMA8.0AT3	5.2-11
1N5370B	5.2-21	1N5946B	5.2-22	1SMA8.5AT3	5.2-11
1N5371B	5.2-21	1N5951B	5.2-22	1SMA9.0AT3	5.2-11
1N5372B	5.2-21	1N5953B	5.2-22	1SMA10AT3	5.2-11
1N5373B	5.2-21	1N5954B	5.2-22	1SMA10CAT3	5.2-12
1N5374B	5.2-22	1N5955B	5.2-22	1SMA11AT3	5.2-11
1N5375B	5.2-22	1N5956B	5.2-22	1SMA11CAT3	5.2-12
1N5376B	5.2-22	1N5985B	5.2-19	1SMA12AT3	5.2-11
1N5377B	5.2-22	1N5987B	5.2-19	1SMA12CAT3	5.2-12
1N5378B	5.2-22	1N5988B	5.2-19	1SMA13AT3	5.2-11
1N5379B	5.2-22	1N5989B	5.2-19	1SMA13CAT3	5.2-12
1N5380B	5.2-22	1N5990B	5.2-19	1SMA14AT3	5.2-11
1N5381B	5.2-22	1N5991B	5.2-19	1SMA14CAT3	5.2-12
1N5382B	5.2-22	1N5992B	5.2-19	1SMA15AT3	5.2-11
1N5383B	5.2-22	1N5993B	5.2-19	1SMA15CAT3	5.2-12
1N5384B	5.2-22	1N5994B	5.2-19	1SMA16AT3	5.2-11
1N5385B	5.2-22	1N5995B	5.2-19	1SMA16CAT3	5.2-12
1N5386B	5.2-22	1N5996B	5.2-19	1SMA17AT3	5.2-11
1N5387B	5.2-22	1N5997B	5.2-19	1SMA17CAT3	5.2-12
1N5388B	5.2-22	1N5998B	5.2-19	1SMA18AT3	5.2-11
1N5404	5.6-13	1N5999B	5.2-19	1SMA18CAT3	5.2-12
1N5406	5.6-13	1N6000B	5.2-19	1SMA20AT3	5.2-11
1N5441A	5.1-25, 5.1-26	1N6002B	5.2-19	1SMA20CAT3	5.2-12
1N5444A	5.1-26	1N6003B	5.2-19	1SMA22AT3	5.2-11
1N5445A	5.1-25	1N6004B	5.2-19	1SMA22CAT3	5.2-12
1N5446A	5.1-26	1N6007B	5.2-20	1SMA24AT3	5.2-11

# Device Index

Device Index	Page	Device Index	Page	Device Index	Page
1SMA24CAT3	5.2-12	1SMB5.0AT3	5.2-13	1SMB160AT3	5.2-14
1SMA26AT3	5.2-11	1SMB6.0AT3	5.2-13	1SMB170AT3	5.2-14
1SMA26CAT3	5.2-12	1SMB6.5AT3	5.2-13	1SMB5913BT3	5.2-24
1SMA28AT3	5.2-11	1SMB7.0AT3	5.2-13	1SMB5915BT3	5.2-24
1SMA28CAT3	5.2-12	1SMB7.5AT3	5.2-13	1SMB5916BT3	5.2-24
1SMA30AT3	5.2-11	1SMB8.0AT3	5.2-13	1SMB5917BT3	5.2-24
1SMA30CAT3	5.2-12	1SMB8.5AT3	5.2-13	1SMB5918BT3	5.2-24
1SMA33AT3	5.2-11	1SMB9.0AT3	5.2-13	1SMB5919BT3	5.2-24
1SMA33CAT3	5.2-12	1SMB10AT3	5.2-13	1SMB5920BT3	5.2-24
1SMA36AT3	5.2-11	1SMB10CAT3	5.2-13	1SMB5921BT3	5.2-24
1SMA36CAT3	5.2-12	1SMB11AT3	5.2-13	1SMB5922BT3	5.2-24
1SMA40AT3	5.2-11	1SMB11CAT3	5.2-13	1SMB5923BT3	5.2-24
1SMA40CAT3	5.2-12	1SMB12AT3	5.2-13	1SMB5924BT3	5.2-24
1SMA43AT3	5.2-11	1SMB12CAT3	5.2-13	1SMB5925BT3	5.2-24
1SMA43CAT3	5.2-12	1SMB13AT3	5.2-13	1SMB5926BT3	5.2-24
1SMA45AT3	5.2-11	1SMB13CAT3	5.2-13	1SMB5927BT3	5.2-24
1SMA45CAT3	5.2-12	1SMB14AT3	5.2-13	1SMB5928BT3	5.2-24
1SMA48AT3	5.2-11	1SMB14CAT3	5.2-13	1SMB5929BT3	5.2-24
1SMA48CAT3	5.2-12	1SMB15AT3	5.2-13	1SMB5930BT3	5.2-24
1SMA51AT3	5.2-11	1SMB15CAT3	5.2-13	1SMB5931BT3	5.2-24
1SMA51CAT3	5.2-12	1SMB16AT3	5.2-13	1SMB5932BT3	5.2-24
1SMA54AT3	5.2-11	1SMB16CAT3	5.2-13	1SMB5933BT3	5.2-24
1SMA54CAT3	5.2-12	1SMB18AT3	5.2-13	1SMB5934BT3	5.2-24
1SMA58AT3	5.2-11	1SMB18CAT3	5.2-13	1SMB5935BT3	5.2-24
1SMA58CAT3	5.2-12	1SMB20AT3	5.2-13	1SMB5936BT3	5.2-25
1SMA60AT3	5.2-11	1SMB20CAT3	5.2-13	1SMB5937BT3	5.2-25
1SMA60CAT3	5.2-12	1SMB22AT3	5.2-13	1SMB5938BT3	5.2-25
1SMA64AT3	5.2-11	1SMB22CAT3	5.2-13	1SMB5939BT3	5.2-25
1SMA64CAT3	5.2-12	1SMB24AT3	5.2-13	1SMB5940BT3	5.2-25
1SMA70AT3	5.2-11	1SMB24CAT3	5.2-13	1SMB5941BT3	5.2-25
1SMA70CAT3	5.2-12	1SMB26AT3	5.2-13	1SMB5942BT3	5.2-25
1SMA75AT3	5.2-11	1SMB26CAT3	5.2-13	1SMB5943BT3	5.2-25
1SMA75CAT3	5.2-12	1SMB28AT3	5.2-13	1SMB5944BT3	5.2-25
1SMA78CAT3	5.2-12	1SMB28CAT3	5.2-13	1SMB5945BT3	5.2-25
1SMA5913BT3	5.2-24	1SMB30AT3	5.2-13	1SMB5946BT3	5.2-25
1SMA5914BT3	5.2-24	1SMB30CAT3	5.2-13	1SMB5947BT3	5.2-25
1SMA5915BT3	5.2-24	1SMB36AT3	5.2-13	1SMB5949BT3	5.2-25
1SMA5916BT3	5.2-24	1SMB36CAT3	5.2-13	1SMB5950BT3	5.2-25
1SMA5917BT3	5.2-24	1SMB40AT3	5.2-13	1SMB5951BT3	5.2-25
1SMA5918BT3	5.2-24	1SMB40CAT3	5.2-13	1SMB5952BT3	5.2-25
1SMA5919BT3	5.2-24	1SMB43AT3	5.2-13	1SMB5953BT3	5.2-25
1SMA5920BT3	5.2-24	1SMB43CAT3	5.2-13	1SMB5954BT3	5.2-25
1SMA5921BT3	5.2-24	1SMB45AT3	5.2-13	1SMC5.0AT3	5.2-16
1SMA5922BT3	5.2-24	1SMB45CAT3	5.2-13	1SMC6.0AT3	5.2-16
1SMA5923BT3	5.2-24	1SMB48AT3	5.2-13	1SMC6.5AT3	5.2-16
1SMA5924BT3	5.2-24	1SMB48CAT3	5.2-13	1SMC7.0AT3	5.2-16
1SMA5925BT3	5.2-24	1SMB51AT3	5.2-13	1SMC7.5AT3	5.2-16
1SMA5926BT3	5.2-24	1SMB51CAT3	5.2-13	1SMC8.0AT3	5.2-16
1SMA5927BT3	5.2-24	1SMB54AT3	5.2-13	1SMC8.5AT3	5.2-16
1SMA5928BT3	5.2-24	1SMB54CAT3	5.2-13	1SMC9.0AT3	5.2-16
1SMA5929BT3	5.2-24	1SMB58AT3	5.2-13	1SMC10AT3	5.2-16
1SMA5930BT3	5.2-24	1SMB58CAT3	5.2-13	1SMC11AT3	5.2-16
1SMA5931BT3	5.2-24	1SMB60AT3	5.2-13	1SMC12AT3	5.2-16
1SMA5932BT3	5.2-24	1SMB60CAT3	5.2-13	1SMC13AT3	5.2-16
1SMA5933BT3	5.2-24	1SMB64AT3	5.2-14	1SMC14AT3	5.2-16
1SMA5934BT3	5.2-24	1SMB64CAT3	5.2-14	1SMC15AT3	5.2-16
1SMA5935BT3	5.2-24	1SMB70AT3	5.2-14	1SMC16AT3	5.2-16
1SMA5936BT3	5.2-25	1SMB70CAT3	5.2-14	1SMC17AT3	5.2-16
1SMA5937BT3	5.2-25	1SMB75AT3	5.2-14	1SMC18AT3	5.2-16
1SMA5938BT3	5.2-25	1SMB78AT3	5.2-14	1SMC20AT3	5.2-16
1SMA5939BT3	5.2-25	1SMB85AT3	5.2-14	1SMC22AT3	5.2-16
1SMA5940BT3	5.2-25	1SMB90AT3	5.2-14	1SMC24AT3	5.2-16
1SMA5941BT3	5.2-25	1SMB100AT3	5.2-14	1SMC26AT3	5.2-16
1SMA5942BT3	5.2-25	1SMB110AT3	5.2-14	1SMC28AT3	5.2-16
1SMA5943BT3	5.2-25	1SMB120AT3	5.2-14	1SMC30AT3	5.2-16
1SMA5944BT3	5.2-25	1SMB130AT3	5.2-14	1SMC33AT3	5.2-16
1SMA5945BT3	5.2-25	1SMB150AT3	5.2-14	1SMC36AT3	5.2-16



# Device Index

Device Index	Page	Device Index	Page	Device Index	Page
1SMC40AT3	5.2-16	2N5038	5.5-13	2N6073	5.7-8
1SMC43AT3	5.2-16	2N5039	5.5-13	2N6073A	5.7-8
1SMC45AT3	5.2-16	2N5086	5.1-3	2N6073B	5.7-8
1SMC48AT3	5.2-16	2N5087	5.1-3	2N6075	5.7-8
1SMC51AT3	5.2-16	2N5088	5.1-3	2N6075A	5.7-8
1SMC54AT3	5.2-16	2N5089	5.1-3	2N6075B	5.7-8
1SMC58AT3	5.2-16	2N5191	5.5-9	2N6107	5.5-4
1SMC60AT3	5.2-16	2N5192	5.5-9	2N6109	5.5-4
1SMC64AT3	5.2-16	2N5194	5.5-9	2N6111	5.5-4
1SMC70AT3	5.2-16	2N5195	5.5-9	2N6237	5.7-3
1SMC75AT3	5.2-16	2N5301	5.5-13	2N6238	5.7-3
1SMC78AT3	5.2-16	2N5302	5.5-13	2N6239	5.7-3
2N930	5.1-19	2N5401	5.1-5	2N6240	5.7-3
2N930A	5.1-19	2N5457	5.1-20	2N6241	5.7-3
2N1893	5.1-18	2N5458	5.1-20	2N6274	5.5-14
2N2219A	5.1-18	2N5459	5.1-20	2N6275	5.5-14
2N2222A	5.1-18	2N5460	5.1-20	2N6277	5.5-14
2N2369A	5.1-19	2N5461	5.1-20	2N6282	5.5-13
2N2484	5.1-19	2N5462	5.1-20	2N6283	5.5-13
2N2904A	5.1-18	2N5484	5.1-20	2N6284	5.5-13
2N2905A	5.1-18	2N5485	5.1-20	2N6285	5.5-13
2N2906A	5.1-18	2N5486	5.1-20	2N6286	5.5-13
2N2907A	5.1-18	2N5551	5.1-5	2N6287	5.5-13
2N3019	5.1-18	2N5555	5.1-21	2N6288	5.5-4
2N3020	5.1-18	2N5631	5.5-13	2N6292	5.5-4
2N3055	5.5-12	2N5639	5.1-21	2N6328	5.5-13
2N3055A	5.5-12, 5.5-15	2N5640	5.1-21	2N6338	5.5-13
2N3251A	5.1-18	2N5655	5.5-8	2N6339	5.5-13
2N3442	5.5-12	2N5656	5.5-8	2N6340	5.5-13
2N3467	5.1-19	2N5657	5.5-9	2N6341	5.5-13
2N3637	5.1-19	2N5668	5.1-20	2N6342	5.7-10
2N3700	5.1-18	2N5684	5.5-14	2N6343	5.7-10
2N3715	5.5-12	2N5685	5.5-14	2N6344	5.7-10
2N3716	5.5-12	2N5686	5.5-14	2N6345	5.7-10
2N3771	5.5-13	2N5878	5.5-12	2N6346	5.7-10
2N3772	5.5-13	2N5879	5.5-12	2N6346A	5.7-12
2N3773	5.5-13	2N5880	5.5-12	2N6347	5.7-10
2N3791	5.5-12	2N5881	5.5-12	2N6347A	5.7-12
2N3792	5.5-12	2N5882	5.5-12	2N6348	5.7-10
2N3799	5.1-19	2N5883	5.5-13	2N6348A	5.7-12
2N3903	5.1-2	2N5884	5.5-13	2N6349	5.7-10
2N3904	5.1-2	2N5885	5.5-13	2N6349A	5.7-12
2N3905	5.1-2	2N5886	5.5-13	2N6379	5.5-14
2N3906	5.1-2	2N6027	5.7-14	2N6387	5.5-5
2N3964	5.1-19	2N6028	5.7-14	2N6388	5.5-5
2N4032	5.1-18	2N6031	5.5-13	2N6426	5.1-4
2N4033	5.1-18	2N6035	5.5-9	2N6427	5.1-4
2N4036	5.1-18	2N6036	5.5-10	2N6431	5.1-19
2N4123	5.1-2	2N6038	5.5-9	2N6436	5.5-13
2N4124	5.1-2	2N6039	5.5-10	2N6437	5.5-13
2N4125	5.1-2	2N6040	5.5-5	2N6438	5.5-13
2N4126	5.1-2	2N6041	5.5-5	2N6488	5.5-6
2N4264	5.1-6	2N6042	5.5-5	2N6491	5.5-6
2N4265	5.1-6	2N6043	5.5-5	2N6497	5.5-4
2N4398	5.5-13	2N6044	5.5-5	2N6498	5.5-4
2N4399	5.5-13	2N6045	5.5-5	2N6504	5.7-5
2N4400	5.1-2	2N6050	5.5-12	2N6505	5.7-5
2N4401	5.1-2	2N6051	5.5-12	2N6506	5.7-5
2N4402	5.1-2	2N6052	5.5-12	2N6507	5.7-5
2N4403	5.1-2	2N6055	5.5-11	2N6508	5.7-5
2N4410	5.1-2	2N6056	5.5-11	2N6509	5.7-5
2N4918	5.5-9	2N6057	5.5-12	2N6517	5.1-5
2N4919	5.5-9	2N6058	5.5-12	2N6519	5.1-5
2N4920	5.5-9	2N6059	5.5-12	2N6520	5.1-5
2N4921	5.5-9	2N6071	5.7-8	2N6547	5.5-12
2N4922	5.5-9	2N6071A	5.7-8	2N6576	5.5-12
2N4923	5.5-9	2N6071B	5.7-8	2N6577	5.5-12

# Device Index

<u>Device Index</u>	<u>Page</u>	<u>Device Index</u>	<u>Page</u>	<u>Device Index</u>	<u>Page</u>
2N6578	5.5-12	68HC05B16	2.5-14	68HC05V7	2.5-11, 2.5-16
2N6609	5.5-13	68HC05B32	2.5-11, 2.5-14	68HC05V12	2.5-16
2N6667	5.5-5	68HC05BD3	2.5-14	68HC05X4	2.5-16
2N6668	5.5-5	68HC05BD5	2.5-14	68HC05X16	2.5-16
2N7000	5.1-22	68HC05BS8	2.5-14	68HC05X32	2.5-16
2N7002LT1	5.1-24	68HC05C0	2.5-11, 2.5-14	68HC08XL36	2.5-11, 2.5-16
2N7008	5.1-22	68HC05C4	2.5-14	68HC705A24	2.5-14, 2.5-18
2SA1774	5.1-12	68HC05C4A	2.5-14	68HC705B5	2.5-14, 2.5-18
2SC4617	5.1-12	68HC05C5	2.5-14, 2.5-17	68HC705B16	2.5-14, 2.5-18
3EZ4.3D5	5.2-21	68HC05C8A	2.5-14	68HC705B32	2.5-14, 2.5-18
3EZ7.5D5	5.2-21	68HC05C9	2.5-15	68HC705BD3	2.5-14, 2.5-18
3EZ8.2D5	5.2-21	68HC05C9A	2.5-15	68HC705BD5	2.5-14, 2.5-18
3EZ9.1D5	5.2-21	68HC05C12A	2.5-14	68HC705BS8	2.5-14
3EZ10D5	5.2-21	68HC05CCV	2.5-15, 2.5-17	68HC705CA8	2.5-14, 2.5-18
3EZ11D5	5.2-21	68HC05CJ4	2.5-15	68HC705C5	2.5-14, 2.5-17, 2.5-18
3EZ13D5	5.2-21	68HC05D9	2.5-15	68HC705C8	2.5-18
3EZ14D5	5.2-21	68HC05D24	2.5-15	68HC705C8A	2.5-14, 2.5-18
3EZ19D5	5.2-21	68HC05D32	2.5-15	68HC705C9	2.5-15, 2.5-18
3EZ22D5	5.2-21	68HC05E6	2.5-15	68HC705C9A	2.5-15
3EZ27D5	5.2-21	68HC05F4	2.5-15	68HC705CCV	2.5-15, 2.5-17
3EZ28D5	5.2-21	68HC05F6	2.5-15	68HC705CJ4	2.5-15
3EZ33D5	5.2-21	68HC05F8	2.5-15	68HC705D9	2.5-15, 2.5-18
3EZ36D5	5.2-21	68HC05G1	2.5-15	68HC705D32A	2.5-11, 2.5-15
3EZ43D5	5.2-21	68HC05G3	2.5-15	68HC705E5	2.5-11
3EZ47D5	5.2-21	68HC05J1	2.5-15	68HC705E6	2.5-15, 2.5-18
3EZ56D5	5.2-21	68HC05J1A	2.5-15, 2.5-17	68HC705F4	2.5-15, 2.5-18
3EZ68D5	5.2-21	68HC05J3	2.5-15	68HC705F6	2.5-15, 2.5-18
3EZ75D5	5.2-22	68HC05K0	2.5-15, 2.5-17	68HC705F8	2.5-15, 2.5-18
3EZ91D5	5.2-22	68HC05K1	2.5-15, 2.5-17	68HC705G1	2.5-15, 2.5-18
3EZ110D5	5.2-22	68HC05K3	2.5-15	68HC705G4	2.5-15
3EZ120D5	5.2-22	68HC05L1	2.5-15	68HC705J1A	2.5-15, 2.5-17, 2.5-18
3EZ130D5	5.2-22	68HC05L2	2.5-15	68HC705J2	2.5-15, 2.5-18
3EZ140D5	5.2-22	68HC05L5	2.5-15	68HC705J3	2.5-15, 2.5-18
3EZ160D5	5.2-22	68HC05L7	2.5-15, 2.5-17	68HC705JP7	2.5-11
3EZ190D5	5.2-22	68HC05L9	2.5-15, 2.5-17	68HC705K1	2.5-15, 2.5-17, 2.5-18
3EZ200D5	5.2-22	68HC05L10	2.5-17	68HC705L1	2.5-15, 2.5-18
3EZ220D5	5.2-22	68HC05L11	2.5-15, 2.5-17	68HC705L2	2.5-15, 2.5-18
3EZ240D5	5.2-22	68HC05L16	2.5-15	68HC705L5	2.5-15, 2.5-18
3EZ330D5	5.2-22	68HC05M4	2.5-15, 2.5-17	68HC705L10	2.5-15
3EZ400D5	5.2-22	68HC05MC4	2.5-11, 2.5-15	68HC705L16	2.5-15, 2.5-18
4N25	5.8-6	68HC05P1	2.5-16	68HC705MC4	2.5-11, 2.5-15, 2.5-18
4N26	5.8-6	68HC05P3	2.5-16	68HC705P3	2.5-18
4N27	5.8-6	68HC05P4	2.5-16	68HC705P6	2.5-16, 2.5-18
4N28	5.8-6	68HC05P6	2.5-16	68HC705P6A	2.5-11
4N29	5.8-7	68HC05P7	2.5-16	68HC705P9	2.5-16, 2.5-18
4N29A	5.8-7	68HC05P8	2.5-16	68HC705RC16	2.5-11, 2.5-16
4N30	5.8-7	68HC05P9	2.5-16	68HC705RC17	2.5-11
4N31	5.8-7	68HC05P9A	2.5-11	68HC705SR3	2.5-16, 2.5-18
4N32	5.8-7	68HC05P18	2.5-11, 2.5-16	68HC705T10	2.5-16, 2.5-18
4N33	5.8-7	68HC05RC16	2.5-16	68HC705V8	2.5-16, 2.5-18
4N35	5.8-6	68HC05RC17	2.5-11	68HC705V12	2.5-16, 2.5-18
4N36	5.8-6	68HC05SC11	2.5-16	68HC705X4	2.5-16, 2.5-18
4N37	5.8-6	68HC05SC21	2.5-16	68HC705X32	2.5-11, 2.5-16, 2.5-18
4N38	5.8-6	68HC05SC24	2.5-16	68HC708XL36	2.5-12, 2.5-16, 2.5-18
4N38A	5.8-6	68HC05SC27	2.5-16		
68HC05A16	2.5-14	68HC05SR3	2.5-11, 2.5-16		
68HC05B4	2.5-14	68HC05T1	2.5-16, 2.5-17	68HC805K3	2.5-11
68HC05B6	2.5-14	68HC05T2	2.5-16, 2.5-17	68HC805P18	2.5-16, 2.5-18
68HC05B8	2.5-14	68HC05T10	2.5-16		

# General Index

## A

A–D Converters	4.5–2
Acceleration Sensors	5.9–12
Adjustable Output Regulators	4.2–4
ADPCM Transcoder	4.7–32
Advanced Comb Filter–II (ACF–II)	4.8–13
Advanced Digital Consumer Division (ADCD) New Market Focus	1.1–1
Advanced Digital Consumer Products	1.0–1
Advanced NTSC Comb Filter	4.8–12
Advanced PAL/NTSC Encoder	4.8–23
AGC Amplifiers	4.1–5
Alternator Voltage Regulator	4.9–12
Amplifier	3.1–13
Amplifier Modules, RF	5.10–31–5.10–35
Amplifiers – Miscellaneous	4.1–6
Amplifiers and Comparators Package Overview	4.1–8
Amplifiers, CATV Distribution, RF	5.10–36–5.10–40
Amplifiers, Integrated Power, RF	5.10–26
Amplifiers, RF	5.10–29–5.10–40
Amplifiers, Wideband Linear, RF	5.10–34
Analog Circuits Package Overview	4.10–4
Analog MPQ Table	4.11–5
Analog-to-Digital Converter (ADC)	2.6–13
Analog-to-Digital Conversion Modules	2.6–13
AND/NAND Gates	3.1–25
Arithmetic Operators	3.1–13
Asynchronous Fast Static RAMs	2.8–5
Audio/Servo Loads, Bipolar Power Transistors	5.5–15
Automotive Direction Indicator	4.9–9
Automotive Electronic Circuits Package Overview	4.9–13
Automotive ISO 9141 Serial Link Driver	4.9–11
Automotive Wash Wiper Timer	4.9–10

## B

Balanced Modulator/Demodulator	4.7–4
Battery Management Circuits	4.2–32
Bipolar A–D Converters	4.5–2
Bipolar Amplifiers	4.1–6
Bipolar Dual Operational Amplifiers	4.1–6
Bipolar Dual Voltage Comparators	4.1–6
Bipolar Power Electronic Lamp Ballasts	5.5–16
Bipolar Power Transistors	5.5–2
Bipolar Power Transistors, Audio	5.5–15
Bipolar Power Transistors, Audio/Servo Loads	5.5–15
Bipolar Power Transistors, DPAK	5.5–10
Bipolar Power Transistors, Electronic Lamp Ballasts	5.5–16
Bipolar Power Transistors, Metal	5.5–11
Bipolar Power Transistors, Plastic	5.5–3, 5.5–6, 5.5–7, 5.5–8
Bipolar Telecommunication Circuit Summary	4.7–35
Bipolar Transistors, Power, RF	5.10–7–5.10–14
Block Erasable Flash EEPROM (BEFLASH)	2.6–13
Bounce Eliminator	3.1–13
Brushless DC Motor Controllers	4.3–4
Buffers	3.1–13

## B (continued)

Buffers, 3–State	3.1–13
Bus Interface	3.1–14

## C

C–Compiler Packages	2.1–20
C–Quam AM Stereo Decoders	4.8–2
Cache/Memory Management Units	2.3–3
Calling Line ID Receiver Evaluation Kit	4.7–33
Calling Line Identification (CLID) Receiver with Ring Detector	4.7–33
Case Outlines, Logic	3.1–54
CATV Distribution Amplifiers, RF	5.10–36–5.10–40
CBM	3.1–16
Central Processing Unit	2.6–2
Central Processing Units	2.6–12
Clock Distribution Chips	3.1–16
Clock Drivers	3.1–16
Closed Loop Brushless Motor Adapter	4.3–7
Closed–Caption Decoder	4.8–14
CMOS	3.1–2
CMOS A–D Converters	4.5–2
CMOS D–A Converters	4.5–3
CMOS Display Drivers	4.6–9
CMOS Dual Programmable Comparators	4.1–6
CMOS Dual Programmable Operational Amplifiers	4.1–6
CMOS Dual Video Amplifiers	4.1–6
CMOS Micropower DC–to–DC Converters	4.2–16
CMOS Micropower Undervoltage Sensing Circuits	4.2–28
CMOS Micropower Undervoltage Sensing Circuits with Output Delay	4.2–29
CMOS Quad Programmable Operational Amplifiers	4.1–6
Coax Cable Drivers	3.1–17
Comb Filters	4.8–3
Communication Modules	2.6–13
Communications Circuits Package Overview	4.7–41
Communications, Power and Signal Technologies Group	5.0–1
Comparators	3.1–17, 4.1–7
Complex Gates	3.1–26
Configurable Timer Module (CTM)	2.6–12
Configuration and Order Information for MMDS/MMEVS	2.5–14
Configuration and Order Information for Other Motorola Development Tools (EVM/EVS/ICS)	2.5–17
Configuration and Order Information for Programmers	2.5–18
Consumer Electronic Circuits Package Overview	4.8–24
Continuously Variable Slope Delta (CVSD) Modulator/Demodulator	4.7–34
Converters	3.1–18
Coprocessors	2.2–10
Cordless Universal Telephone Interface	4.7–22
Counters	3.1–18
CPSTG Surface Mount Information	5.11–2
CPU16	2.6–12
CPU32	2.6–12
Critical Conduction SMPS Controller	4.2–22
CSIC Microcontroller Division World Wide Web Site	2.5–23
Current Mode Switching Regulator	4.7–31

# General Index

## D

D–A Converters	4.5–3
D2PAK	4.11–5
Data Communication Devices	2.2–12
Data Conversion Package Overview	4.5–4
DC Servo Motor Controller/Driver	4.3–8
Decoder	3.1–22
Decoder/Demultiplexers	3.1–20
Decoders	3.1–20
Deflection	4.8–3
Demultiplexers	3.1–20
Design-In Software Packages	2.1–19
Detectors	3.1–21
Developer's Workbench	2.7–6
Device Index, Logic	3.1–40
Device Nomenclatures, Logic	3.1–50
Digital I/O and Special Functions	2.6–2
Digital Signal Processors	2.1–1
Digital-to-Analog Conversion	2.6–2
Digitally Controlled Video Processor for Multimedia Applications	4.8–7
Direct Memory Access (DMA)	2.6–13
Discrete Products	5.0–1
Discrete Transistors, RF	5.10–2–5.10–19
Discrete Wireless Transmitter Devices, RF	5.10–15–5.10–16
Display Decode Drivers	3.1–21
Dividers	3.1–21
DMA Controllers	2.2–10
Double-Ended Controllers	4.2–15
DPAK	4.11–5, 5.5–10
DPAK–Surface Mount, Bipolar Power Transistors	5.5–10
DRAM Modules	2.8–9
Driver	3.1–21
DSP Development Tools	2.1–18
DTL Circuits	3.1–52
Dual Bipolar Comparators	4.1–7
Dual Channel Controllers	4.2–23
Dual CMOS Comparators	4.1–7
Dual Comparators	4.1–7
Dual Data Link Controller	4.7–17
Dual High–Side Switch	4.9–6
Dual Operational Amplifier and Dual Voltage Comparator	4.1–6
Dual Operational Amplifiers	4.1–3
Dual Timing Circuits	4.10–2
Dual Tone Multiple Frequency Receiver	4.7–15
Dual Universal Asynchronous/Synchronous Receiver Transmitter (DUART)	2.6–13
Dynamic RAMs	2.8–7
Dynamic RAMs (HCMOS)	2.8–8

## E

Easy Switcher Single-Ended Controllers with On–Chip Power Switch	4.2–14
ECL	3.1–3
ECLinPS	3.1–51
ECLinPS Lite	3.1–51, 3.1–53

## E (continued)

EDACs	3.1–21
EIA Standard Line Drivers	4.6–7
EIA Standard Line Receivers	4.6–7
EIA–232–E/V.28 CMOS Drivers/Receivers	4.6–7
Electronic Ignition	4.9–2
Electronic Telephone	4.7–19
Electronic Telephone Circuits	4.7–19
Embedded Controllers	2.2–5
Encoder/Decoder	3.1–22
Encoders	3.1–21, 4.8–3
Enhanced Closed–Caption Decoder	4.8–15
Enhanced Ethernet Transceiver	4.6–2
Entertainment Radio Receiver Circuits – Audio Amplifiers	4.8–2
Entertainment Receiver RF/IF	4.8–2
Evaluation Boards, RF Monolithic Integrated Circuits	5.10–23
Expanders	3.1–22
EZFETs, HDTMOS Power MOSFETs	5.4–9
80 mA Micropower Voltage Regulator	4.2–5

## F

FACT	3.1–51
Family Wideband General Purpose Amplifiers	4.1–5
FAST	3.1–50
Fast Static RAM Modules	2.8–6
Fast Static RAMs	2.8–2
FETs, TMOS Power MOSFETs	5.4–1
Fiber Distributed Data Interface	2.2–13
Fiber Optic Receivers, RF	5.10–36
Field Programmable Gate Array	3.1–22
Field Programmable Gate Arrays (FPGA)	3.1–5
Field–Effect Transistors, Small Signal	5.1–20, 5.1–42
Fixed Voltage Medium and Low Dropout Regulators	4.2–3
Flash EEPROM (FLASH)	2.6–13
Flash Memory	2.8–7
Flip–Flop/Registers	3.1–22
Flip–Flops	3.1–22
Footprints for Soldering, CPSTG	5.11–5
Freeware Bulletin Board	2.5–23
Fuzzy Logic	2.6–26
5.0 V, 200 M–Bit/Sec PR–IV Hard Disk Drive Read Channel	4.6–5

## G

GaAs Power Amplifier Support IC	4.2–10
GaAs Rectifiers Power Manager	5.6–14
Gas Sensors	5.9–12
Gates	
AND/NAND	3.1–25
Complex	3.1–26
NOR	3.1–28
OR	3.1–28
XOR/XNOR	3.1–27
General Purpose I/O	2.2–12
General Purpose Timer (GPT)	2.6–12

# General Index

## H

H4EPlus Series Gate Arrays	1.1-7
Hard Disk Drive Read Channel	4.6-8
HDTMOS Power MOSFETs	5.4-3
HDTMOS Power MOSFETs, EZFET	5.4-4, 5.4-17
HDTMOS Power MOSFETs, Micro8	5.4-4, 5.4-17
Hex EIA-485 Transceiver with Three-State Outputs	4.6-4
HF Transistors, RF	5.10-7
High Cell Density (HDTMOS)	5.4-3
High Frequency Amplifiers	4.1-5
High Side TMOS Driver	4.9-8
High-Side Driver Switch	4.3-4
High-Speed CMOS	3.1-51
How to Access Freeware	2.6-26
HTL Circuits	3.1-52
Hybrid Power Modules	5.3-1

## I

ICU	3.1-29
IEEE 802.3 Transceivers	4.6-8
IGBTs (Insulated Gate Bipolar Transistor), Power MOSFETs	5.4-7, 5.4-22
IGBTs, Hybrid Power Modules	5.3-2
Ignition IGBTs, Power MOSFETs	5.4-22
Industrial Control Unit	3.1-29
Infrared Transceiver	4.7-4
Inkjet Drivers	4.6-8
Insulated Gate Bipolar Transistor, Power MOSFETs	5.4-7, 5.4-22
Insulated Gate Bipolar Transistors, Hybrid Power Modules	5.3-2
Integrated Circuits, RF Monolithic	5.10-23-5.10-28
Integrated Circuits, RF Monolithic, Evaluation Boards	5.10-23
Integrated Power Amplifiers, RF	5.10-26
Integrated Power Stage IGBTs, Hybrid Power Modules	5.3-2
Integrated Processors	2.2-7
Integrated Services Digital Network	4.7-15
Integration Modules	2.6-12
Interface Circuits Package Overview	4.6-10
Intermodule Bus Peripherals	2.6-12
Inverter/Buffers, 2-State	3.1-29
Inverters	3.1-29
ISDN Voice/Data Circuits	4.7-15
ISO 8802-3[IEEE 802.3] 10BASE-T Transceiver	4.6-3

## L

Land Mobile/Portable Amplifiers, RF	5.10-31-5.10-33
Latches	3.1-30
LCD Driver Product Summary	1.1-3
LCX	3.1-52
Line Drivers	4.6-7
Line Receivers	4.6-7
Line Transceivers	4.6-7
Linear Amplifiers, Wideband, RF	5.10-34-5.10-35
Linear Four-Quadrant Multipliers	4.10-2
Linear Transistors, RF	5.10-12-5.10-13
Linear Voltage Regulators	4.2-2

## L (continued)

Linear Voltage Regulators – Adjustable Output	4.2-4
Linear Voltage Regulators – Fixed Output	4.2-2
Literature	1.1-8
Logic Device Index	3.1-40
Logic Devices	
CMOS	3.1-2
ECL	3.1-3
Family Comparison	3.1-1
How to Choose	3.1-1
TTL	3.1-2
Logic Functions	3.1-12
LonWorks Products	2.7-1
Low Dropout Regulator	4.2-9
Low Side Protected Switch	4.9-7
LS – Low Power Schottky	3.1-50
LVQ	3.1-52

## M

M5C Series Gate Arrays/M5CB Series Standard Cells	1.1-6
M6800 Series Microprocessors and Peripherals	2.6-10
M68000 Family	2.2-1
M68300 Family	2.6-19
M68HC05 CSIC Family	2.5-2
M68HC05 Industry Solutions	2.5-2
68HC05 General-Purpose Microcontrollers	2.5-2
Automotive	2.5-2
Computer	2.5-2
Consumer	2.5-3
Industrial	2.5-3
Low-Voltage Microcontrollers	2.5-2
Telecommunications	2.5-3
Television and Video	2.5-3
M68HC05 Family	2.6-22
M68HC05 Microcontroller Development Tools	
Choosing Between the MMEVS and MMDS	2.5-14
Modular Architecture Benefits	2.5-14
M68HC08 Family	2.5-13
M68HC11 Family	2.6-2, 2.6-22
M68HC16 Family	2.6-14
M88000 RISC Family	2.3-1
Masked ROM (MRM)	2.6-13
Math Coprocessor	2.6-2
MC2681 — Dual Universal Asynchronous Receiver/Transmitter, DUART	2.2-12
MC68000 — The 16-Bit Foundations	2.2-4
MC68008 — An 8-Bit Compatible Competitor	2.2-4
MC68010 — A Virtual Memory Enhancement	2.2-4
MC68020 — The Original 32-Bit Performance Standard	2.2-4
MC68030 — The Second Generation 32-Bit MPU	2.2-3
MC68040 — Third-Generation 32-Bit Microprocessor	2.2-3
MC68060 — Superscaler 32-Bit Microprocessor	2.2-3
MC68184 — Broadband Interface Controller	2.2-10
MC68185 — Twisted-Pair Modem	2.2-11
MC68194 — Carrierband Modem	2.2-11
MC68195 — LocalTalk Adaptor	2.2-11
MC68230 — Parallel Interface/Timer, PI/T	2.2-12
MC68302 — Integrated Multiprotocol Processor	2.2-8
MC68306 — Integrated 68EC00 Processor	2.2-8

# General Index

## M (continued)

MC68330 — Integrated CPU32 Processor .....	2.2-8
MC68331 — 32-Bit Microcontroller .....	2.2-8
MC68332 — 32-Bit Microcontroller .....	2.2-9
MC68334 — 32-Bit Microcontroller .....	2.2-9
MC68340 — Integrated Multiprotocol Processor with DMA ..	2.2-9
MC68440 — Dual Direct Memory Access Controller, DDMA .....	2.2-10
MC68450 — DMA Controller, DMAC .....	2.2-10
MC68605 — X.25 Protocol Controller, XPC .....	2.2-11
MC68606 — Multi-Link LAPD Controller CCITT Q.920/Q.921, LAPD .....	2.2-11
MC68681 — Dual Universal Asynchronous Receiver/Transmitter, DUART .....	2.2-12
MC68824 — Token Bus Controller, TBC .....	2.2-10
MC68836 — FDDI Clock Generator .....	2.2-13
MC68837 — Elasticity Buffer and Link Manager .....	2.2-13
MC68838 — Media Access Controller .....	2.2-13
MC68839 — FDDI System Interface .....	2.2-13
MC68851 — Paged Memory Management Unit, PMMU .....	2.2-10
MC68881 — A Floating Point Coprocessor .....	2.2-10
MC68882 — Enhanced Floating Point Coprocessor .....	2.2-10
MC68901 — Multifunction Peripheral, MFP .....	2.2-12
MC68EC000 — Low-Powered HCMOS Embedded Controller .....	2.2-6
MC68EC020 — 32-Bit Embedded Controller .....	2.2-6
MC68EC030 — 32-Bit Enhanced Embedded Controller .....	2.2-6
MC68EC040 — 32-Bit High-Performance Embedded Controller .....	2.2-5
MC68F333 — 32-Bit Microcontroller .....	2.2-9
MC68HC000 — A Micropower Alternative .....	2.2-4
MC68HC001 — Low Power HCMOS 8-/16-/32-Bit Microprocessor .....	2.2-4
MC68HC05 Microcontrollers .....	2.5-6
MC88100RC .....	2.3-2
MC88200RC — 16-Kilobyte Cache/Memory Management Unit .....	2.3-3
MECL 10H .....	3.1-50
MECL 10K .....	3.1-50
MECL III .....	3.1-52
Medium Power MOSFETs, TMOS .....	5.4-9, 5.4-18
Medium Power Transistors, RF .....	5.10-14-5.10-16
Memory Modules .....	2.6-13
Memory Products .....	2.8-1
Memory Support .....	3.1-31
Metal .....	5.5-11
Metal Gate 14000 Series CMOS .....	3.1-51
Metal TO-204AA, TO-204AE, Bipolar Power Transistors ..	5.5-11
Mfax — Touch-Tone FAX for Technical Data .....	6.1-1
MI-Bus Interface Stepper Motor Controller .....	4.9-9
Micro-8 .....	4.11-5
Micro8 Products .....	5.4-8
Microcomputer Components, Single-Chip Microcontrollers (MCU) .....	2.5-1, 2.6-1
Microcontroller Development Tools .....	2.5-14, 2.6-22
Microcontroller Electronic Bulletin Board .....	2.6-26
Micropower Voltage Regulator for External Transistor .....	4.2-6

## M (continued)

Micropower Voltage Regulators for Portable Applications ...	4.2-5
Micropower Voltage Regulators with On/Off Control .....	4.2-7
Microprocessor Voltage Regulator and Supervisory Circuit ..	4.2-9
Microprocessors .....	2.2-2, 2.3-2
Microwave Transistors, RF .....	5.10-10-5.10-11
MiniMOS Products .....	5.4-8, 5.4-17
Miscellaneous Logic .....	3.1-31
Modular Microcontroller Families .....	2.6-22
Modular Microcontrollers .....	2.6-12
Modulator .....	4.8-4
Monitor On Screen Display (MOSD) .....	1.1-4
Monitor Subsystem .....	4.8-4
Monolithic Integrated Circuits, RF .....	5.10-23-5.10-28
MOSFET/IGBT Drivers .....	4.2-38
MOSFETs, Power, RF .....	5.10-4-5.10-5
MOSFETs, Power, TMOS .....	5.4-1
Motor Controllers .....	4.3-4
Motorola Programmable Array (MPA) .....	3.1-5
Motorola Programmable Logic (MPA) .....	3.1-22
Motorola SPS World Marketing Internet Server .....	6.1-1
Motorola Technical Training Courses .....	6.1-7
MPC105 PCI Bridge/Memory Controller .....	2.4-15
MPC106 PCI Bridge/Memory Controller .....	2.4-16
MPC601 RISC Microprocessor .....	2.4-2
MPC602 RISC Microprocessor .....	2.4-3
MPC603 RISC Microprocessor .....	2.4-3
MPC603e RISC Microprocessor .....	2.4-6
MPC604 RISC Microprocessor .....	2.4-9
MPC604e RISC Microprocessor .....	2.4-9
MPC620 RISC Microprocessor .....	2.4-13
MPC821/MPC823 RISC Microprocessors and the MC68328 DragonBall Integrated Processor .....	1.1-2
Multi-Channel Communications Interface (MCCI) .....	2.6-13
Multi-integrated Devices, Small Signal .....	5.1-43
Multiplexer/Data Selectors .....	3.1-31
Multipliers .....	4.10-2
Multistandard Video/Timebase Processor .....	4.8-11
Multivibrators .....	3.1-33

## N

NAND Gates .....	3.1-25
Narrowband Dual Conversion Receivers — FM/FSK — VHF ..	4.7-3
Narrowband FM Coilless Detector IF Subsystem .....	4.7-7
Narrowband FM Receiver .....	4.7-6
Narrowband Single Conversion Receivers — VHF .....	4.7-2
Network Devices .....	2.2-10
Neuron Chips .....	2.7-2
NOR Gates .....	3.1-28

## O

Octal Serial Switch .....	4.9-5
On-Chip Memory .....	2.6-2
On-Line Help .....	2.5-23, 2.6-26
One-Time Programmable (OTP) / Emulator MCUs .....	2.5-9
Operational Amplifiers .....	4.1-2

# General Index

## O (continued)

Optoelectronic Devices	5.8–1
Optoelectronic Devices, 6-Pin Devices	5.8–1, 5.8–5
Optoelectronic Devices, Optoisolators	5.8–1, 5.8–2
Optoelectronic Devices, POWER OPTO Isolators	5.8–1, 5.8–10
Optoisolators, Optoelectronic Devices	5.8–1, 5.8–2
Optoisolators, SO–8	5.8–9
OR Gates	3.1–28
Ordering Information, Logic	3.1–50
Oscillator/Timers	3.1–34
Oscillators	3.1–33
Over/Undervoltage Protection Circuit	4.2–27
Overvoltage Crowbar Sensing Circuit	4.2–27
120 mA Micropower Voltage Regulator	4.2–6

## P

Packaging Specifications, CPSTG	5.12–7
Parity Checkers	3.1–34
PBX Architecture (Analog Transmission)	4.7–12
PCI (peripheral component interconnect) bus	2.4–15
PCM Monocircuits Codec–Filters (CMOS LSI)	4.7–12
Peripheral Drivers	4.6–8
Peripherals	2.1–5, 2.1–12, 2.1–19
Phase–Locked Loop	3.1–34
Phase–Locked Loop Components	4.7–38
Pin Conversion, Logic	3.1–85
PLCC	4.11–5
PLL Frequency Synthesizers	4.7–38
PLL Tuning Circuit with 3–Wire Bus	4.8–21
PLL Tuning Circuit with I2C Bus	4.8–19, 4.8–21, 4.8–22
PLL Tuning Circuits with 3–Wire Bus	4.8–18
PLL Tuning Circuits with I2C Bus	4.8–20
Power Audio Output Stage	5.5–15
Power Bipolar Transistors, RF	5.10–7–5.10–14
Power Controllers	4.3–2
Power Factor Controllers	4.2–24, 4.2–25
Power Management Controller	4.2–10
Power MOSFETs, D2PAK	5.4–11, 5.4–19, 5.4–21
Power MOSFETs, D3PAK	5.4–12
Power MOSFETs, DPAK	5.4–10, 5.4–18, 5.4–20
Power MOSFETs, High Power Products	5.4–16
Power MOSFETs, Ignition IGBTs	5.4–7
Power MOSFETs, Logic Level Packages	5.4–20, 5.4–21
Power MOSFETs, RF	5.10–4–5.10–5
Power MOSFETs, SO–8	5.4–8, 5.4–17
Power MOSFETs, SOT–223	5.4–9, 5.4–18, 5.4–20
Power MOSFETs, TMOS	5.4–1
Power MOSFETs, TO–220AB	5.4–13, 5.4–19, 5.4–21
Power MOSFETs, TO–247 Isolated Mounting Hole	5.4–15
Power MOSFETs, TO–264 High Power Products	5.4–16
Power MOSFETs, TO–3PBL	5.4–16
POWER OPTO Isolators, Optoelectronic Devices	5.8–1, 5.8–10
Power Supply Circuits Package Overview	4.2–40
Power/Motor Control Circuits Package Overview	4.3–11
PowerPC RISC Family	2.4–1

## P (continued)

Precision Low Voltage References	4.4–2
Prescalers	3.1–34
Pressure Sensors, 4–Pin	5.9–6, 5.9–8, 5.9–9
Pressure Sensors, 6–Pin	5.9–6, 5.9–8, 5.9–9
Pressure Sensors, Compensated and Calibrated (On–Chip)	5.9–7, 5.9–8
Pressure Sensors, Compensated and Calibrated, Medical Grade	5.9–7
Pressure Sensors, High Impedance	5.9–7
Pressure Sensors, Motorola’s Patented X–ducer	5.9–2
Pressure Sensors, Packaging Options	5.9–14
Pressure Sensors, Signal Conditioned	5.9–7, 5.9–9
Pressure Sensors, Uncompensated	5.9–7
Programmable Logic	3.1–5, 3.1–22
Programmable Telephone Line Interface Circuit with Loudspeaker Amplifier	4.7–23
Programmable Delay Chips	3.1–35
PROMs, Logic	3.1–35
Pulse–Width Modulation	2.6–2

## Q

Quad Bipolar Comparators	4.1–7
Quad CMOS Comparators	4.1–7
Quad Comparators	4.1–7
Quad Fuel Injector Driver	4.9–4
Quad Operational Amplifiers	4.1–4
Quad Programmable Operational Amplifier	4.1–6
Queued Analog-to-Digital Converter (QADC)	2.6–13
Queued Serial Module (QSM)	2.6–13

## R

RAMs, Logic	3.1–35
Read/Write Channel	4.6–8
Receiver Functions, RF	5.10–24–5.10–25
Receivers	3.1–35
Rectifier Numbering System	5.6–2
Rectifiers	5.6–1
Rectifiers, Application Specific	5.6–3
Rectifiers, Automotive Transient Suppressors	5.6–3
Rectifiers, Axial Lead Schottky	5.6–6
Rectifiers, Axial Lead Ultrafast	5.6–10
Rectifiers, Fast Recovery	5.6–13
Rectifiers, GaAs Power Manager	5.6–14
Rectifiers, General Purpose	5.6–13
Rectifiers, Low VF Schottky	5.6–3
Rectifiers, MEGAHERTZ	5.6–3
Rectifiers, POWER TAP II	5.6–9, 5.6–12
Rectifiers, SCANSWITCH	5.6–3
Rectifiers, Surface Mount Schottky	5.6–4
Rectifiers, Surface Mount Ultrafast	5.6–10
Rectifiers, SWITCHMODE	5.6–4
Rectifiers, TO–218 Types and TO–247 Schottky	5.6–8
Rectifiers, TO–218 Types Ultrafast	5.6–12
Rectifiers, TO–220 Type Schottky	5.6–7
Rectifiers, TO–220 Type Ultrafast	5.6–11
Rectifiers, TO–247 Ultrafast	5.6–12

# General Index

## R (continued)

Rectifiers, Ultrafast .....	5.6–10
Register Files .....	3.1–36
Registers .....	3.1–36
RF Amplifier Modules .....	5.10–31–5.10–35
RF Amplifiers .....	5.10–29–5.10–40
RF CATV Distribution Amplifiers .....	5.10–36–5.10–40
RF Communications .....	4.7–2
RF Discrete Transistors .....	5.10–2–5.10–19
RF Front End ICs .....	4.7–2
RF HF Transistors .....	5.10–7
RF Integrated Power Amplifiers .....	5.10–26–5.10–28
RF Land Mobile/Portable Amplifiers .....	5.10–31–5.10–33
RF Linear Transistors .....	5.10–12–5.10–13
RF Medium Power Transistors .....	5.10–14–5.10–16
RF Microwave Transistors .....	5.10–10–5.10–11
RF Monolithic Integrated Circuits .....	5.10–23–5.10–28
RF Power Bipolar Power Transistors .....	5.10–7–5.10–14
RF Power MOSFETs .....	5.10–4–5.10–5
RF Products .....	5.10–1
RF Receiver Functions .....	5.10–24–5.10–25
RF Small Signal Transistors .....	5.10–16–5.10–21
RF Switching .....	5.10–24
RF Transmitter Functions .....	5.10–25–5.10–27
RF TV Transmitters .....	5.10–35
RF UHF Transistors .....	5.10–8–5.10–9
RF VHF Transistors .....	5.10–7–5.10–8
RF, LDMOS .....	5.10–5–5.10–6, 5.10–15, 5.10–25, 5.10–26, 5.10–27, 5.10–31–5.10–34
RF, Micro-8 .....	5.10–24
RF, PFP-16 .....	5.10–26
RF, PLD-1 .....	5.10–15
RF, PLD-1.5 .....	5.10–5
RF, SC-70/SOT-323 .....	5.10–19–5.10–20
RF, SC-70ML/SOT-363 .....	5.10–19
RF, SO-16 .....	5.10–24–5.10–28
RF, SO-8 .....	5.10–9, 5.10–15, 5.10–19–5.10–27
RF, SOT-143 .....	5.10–15, 5.10–19–5.10–21, 5.10–24–5.10–25
RF, SOT-23 .....	5.10–18, 5.10–21–5.10–22
RF, SOT-89 .....	5.10–15
RF, TQFP-48 .....	5.10–24
RF, TSSOP-16 .....	5.10–24–5.10–25, 5.10–27–5.10–28
RF, TSSOP-16HS .....	5.10–27
RF, TSSOP-20 .....	5.10–25
RF, TSSOP-20HS .....	5.10–28

## S

Schmitt Triggers .....	3.1–36
Schottky Diodes, Small Signal .....	5.1–33
Scorpion Graphics Processor (MC92100) .....	1.1–5
SCSI Bus Terminators .....	3.1–36
SCSI Regulator .....	4.2–11
Second Generation S/T-Interface Transceivers .....	4.7–16
Second Generation U-Interface Transceivers .....	4.7–16
Sensors .....	5.9–1
Serial Communication .....	2.6–2

## S (continued)

Serial EPROMs .....	3.1–36
Shift Registers .....	3.1–36
Sigma-Delta A-D Converters .....	4.5–2
Sigma-Delta D-A Converters .....	4.5–3
Silicon Controlled Rectifiers (SCRs), Thyristors .....	5.7–2
Single Bipolar Comparators .....	4.1–7
Single CMOS Comparators .....	4.1–7
Single Comparators .....	4.1–7
Single Operational Amplifiers .....	4.1–2
Single Timing Circuits .....	4.10–2
Single-Chip Integration Module (SCIM) .....	2.6–12
Single-Ended Controllers .....	4.2–12
Single-Ended Controllers with On-Chip Power Switch .....	4.2–14
Single-Ended GreenLine Controllers .....	4.2–18
Small Signal Bipolar Transistors .....	5.1–2, 5.1–41
Small Signal GreenLine Devices .....	5.1–41
Small Signal Integrated Relay/Solenoid Driver .....	5.1–43
Small Signal Low Voltage Bias Stabilizer .....	5.1–43
Small Signal Multi-Integrated Devices .....	5.1–43
Small Signal Transistors .....	5.1–1
Small Signal Transistors, RF .....	5.10–16–5.10–21
Small Signal Tuning and Switching Diodes .....	5.1–25, 5.1–35, 5.1–42
Small Signal, DO-204AA (DO-7) .....	5.1–26, 5.1–32
Small Signal, FETs .....	5.1–23, 5.1–42
Small Signal, HDTMOS .....	5.1–42
Small Signal, JFETs .....	5.1–20
Small Signal, SC-59 .....	5.1–11, 5.1–36, 5.1–42
Small Signal, SC-70/SOT-323 .....	5.1–11, 5.1–14, 5.1–24, 5.1–31, 5.1–34, 5.1–36, 5.1–42
Small Signal, Schottky Diodes .....	5.1–33, 5.1–34
Small Signal, SO-14 .....	5.1–40
Small Signal, SO-16 .....	5.1–9, 5.1–40
Small Signal, SOD-123 .....	5.1–42
Small Signal, SOT-143 .....	5.1–43
Small Signal, SOT-223 .....	5.1–16, 5.1–24, 5.1–32
Small Signal, SOT-23 .....	5.1–10, 5.1–23, 5.1–28, 5.1–31, 5.1–36, 5.1–42, 5.1–43
Small Signal, SOT-363 .....	5.1–11, 5.1–23, 5.1–34, 5.1–43
Small Signal, SOT-416/SC-90 .....	5.1–12
Small Signal, TMOS MOSFETs .....	5.1–22
Small Signal, TO-116 .....	5.1–9, 5.1–40
Small Signal, TO-205AD (TO-39) .....	5.1–18
Small Signal, TO-206AA (TO-18) .....	5.1–18
Small Signal, TO-226AA (TO-92) .....	5.1–2, 5.1–20, 5.1–22, 5.1–28
Small Signal, TO-226AC (TO-92) .....	5.1–27, 5.1–31, 5.1–32, 5.1–34, 5.1–36
Small Signal, TO-226AE (TO-92) .....	5.1–3, 5.1–22
Small Signal, TO-236AB .....	5.1–10, 5.1–23, 5.1–31, 5.1–32, 5.1–34, 5.1–36, 5.1–42
SMARTDISCRETES Products .....	5.4–7
Smoke Detectors (CMOS) .....	4.10–3
SO-8, Optoisolators .....	5.8–9
SO-8, Thyristors .....	5.7–14
SOE Case, Ceramic, RF .....	5.10–20
SOE Case, Plastic, RF .....	5.10–17–5.10–19
SOIC .....	4.11–5



# General Index

## S (continued)

SOT-23 (5 Pin)	4.11-5
SOT-89 (3 Pin)	4.11-5
SOT-89 (5 Pin)	4.11-5
Speakerphone Integrated Circuits	4.7-30
Speakerphones	4.7-25
Special Functions	4.9-3
Special Logic Circuits	3.1-52
Special Regulators	4.2-8
Special Switching Regulator Controllers	4.2-23
Specialized Control Modules	2.6-13
Speech Networks	4.7-21
Standby RAM (SRAM)	2.6-13
Standby RAM with TPU Emulation (TPURAM)	2.6-13
Stepper Motor Driver	4.3-9
Subscriber Loop Interface Circuit (SLIC)	4.7-11
Supervisory Circuits	4.2-27
Surface Mount Information, CPSTG	5.11-2
Surface Mount Products, Bipolar Power Transistors	5.5-10
Surface Mount Products, Optoelectronic Devices	5.8-9
Surface Mount Products, Power MOSFETs	5.4-8, 5.4-9, 5.4-10, 5.4-11, 5.4-12, 5.4-17, 5.4-18, 5.4-19, 5.4-20
Surface Mount Products, Rectifiers	5.6-4
Surface Mount Products, RF	5.10-9, 5.10-15, 5.10-18-5.10-26
Surface Mount Products, Small Signal	5.1-9, 5.1-10, 5.1-23, 5.1-28, 5.1-32, 5.1-36, 5.1-37, 5.1-41
Surface Mount Products, Thyristors	5.7-7
Surface Mount Products, TVS/Zeners	5.2-9, 5.2-24
Switching Regulator Control Circuits	4.2-12
SWITCHMODE Rectifiers	5.6-4
Synchronous Fast Static RAMs	2.8-3
Synthesizers	3.1-38
System Integration Module (SIM)	2.6-12

## T

Tape and Reel Configurations	4.11-2
Tape and Reel Information Table	4.11-4
Tape and Reel Specifications, CPSTG	5.12-2
Tape and Reel, Logic	3.1-86
Tape/Reel and Ammo Pack	4.11-5
Technical Data and Literature	6.1-2, 6.1-6
Technical Data Services	6.1-1
Technical Training Centers	6.1-13
Telecommunications	4.7-11
Telephone Accessory Circuits	4.7-31
Telephone Accessory Circuits - Audio Amplifiers	4.7-31
Telephone Line Interface	4.7-24
Telephone Line Interface and Speakerphone Circuit	4.7-29
Telephone Speech Network with Dialer Interface	4.7-21
Terminators, SCSI Bus	3.1-36
Third Party Developers for 68HC05 and 68HC705 Family MCUs	2.5-19
Third-Party Development Tools	2.6-27
Third-Party Support	2.6-27
Thyristors, High Voltage Bidirectional TVS Devices	5.7-14
Thyristors, Programmable Unijunction Transistors	5.7-14

## T (continued)

Thyristors, SIDACs	5.7-14
Thyristors, Silicon Bidirectional Switch	5.7-14
Thyristors, Silicon Controlled Rectifiers	5.7-2
Thyristors, SOT-223	5.7-2, 5.7-7
Thyristors, TO-220AB	5.7-4, 5.7-8
Thyristors, TO-225AA	5.7-3, 5.7-7
Thyristors, TO-226AA (TO-92)	5.7-2, 5.7-7
Thyristors, TRIACs, General Purpose	5.7-7
Thyristors, Triggers	5.7-14
Time Processor Unit (TPU)	2.6-12
Timer	2.6-2
Timer Module (TM)	2.6-13
Timers	2.6-12
Timing Circuits	4.10-2
TMOS MOSFETs, Small Signal	5.1-22, 5.1-42
TMOS Power MOSFETs	5.4-1
TMOS Power MOSFETs Numbering System	5.4-2
TMOS V	5.4-5
TO-218, Bipolar Power Transistors	5.5-6
TO-220AB, Bipolar Power Transistors	5.5-3
TO-220AB, Thyristors	5.7-4, 5.7-8
TO-225AA, Bipolar Power Transistors	5.5-8
TO-225AA, Thyristors	5.7-3, 5.7-7
TO-226AA (TO-92), Thyristors	5.7-2, 5.7-7
TO-247, Bipolar Power Transistors	5.5-7
TO-264, Bipolar Power Transistors	5.5-8
TO-92	4.11-5
TO-92, Thyristors	5.7-14
Tone Ringers	4.7-20
Transceivers	3.1-38
Transient Voltage Suppressors	5.2-2
Transient Voltage Suppressors, Axial Ledged for Through-hole Designs	5.2-2
Transient Voltage Suppressors, General Purpose	5.2-2
Transient Voltage Suppressors, Mini Mosorb	5.2-2
Transient Voltage Suppressors, Mosorb	5.2-6
Transient Voltage Suppressors, Overvoltage Transient	5.2-18
Transient Voltage Suppressors, SMA	5.2-11
Transient Voltage Suppressors, SMB	5.2-13
Transient Voltage Suppressors, SMC	5.2-16
Transient Voltage Suppressors, Surface Mount	5.2-9
Transient Voltage Suppressors, Surmetic 40	5.2-4, 5.2-21
Transistors, Discrete, RF	5.10-2-5.10-19
Transistors, Medium Power, RF	5.10-14-5.10-16
Transistors, Power Bipolar, RF	5.10-7-5.10-14
Transistors, Power MOSFETs, RF	5.10-4-5.10-5
Transistors, Small Signal, RF	5.10-16-5.10-21
Translators	3.1-38
Transmitter Functions, RF	5.10-25-5.10-27
Transmitters - AM/FM/FSK	4.7-3
TRIACs, Thyristors	5.7-7
Triple 8-Bit A/D Converter	4.8-9
Triple 8-Bit D/A Converter	4.8-8
TTL	3.1-2
Tuner PLL Circuits	4.8-4

# General Index

## T (continued)

TV Decoder	4.8-3
TV IF Circuits	4.8-3
TV Picture-in-Picture	4.8-3
TV Transmitters, RF	5.10-35
TVS/Zeners	5.2-1
TVS/Zeners, DO-204AA (DO-7)	5.2-34
TVS/Zeners, DO-204AH (DO-35)	5.2-19, 5.2-34
TVS/Zeners, SMA	5.2-24
TVS/Zeners, SMB	5.2-24
TVS/Zeners, SMC	5.2-16
TVS/Zeners, SOD-123	5.2-24, 5.2-29
TVS/Zeners, SOT-23	5.2-9, 5.2-24, 5.2-27
2-Wire ISDN Universal Digital Loop Transceiver II (UDLT II)	4.7-19
2-Wire Universal Digital Loop Transceiver (UDLT)	4.7-18
28-Channel Inkjet Driver	4.6-8
300 Baud FSK Modems	4.7-32

## U

U-Interface Transceiver Evaluation Kit	4.7-17
UHF Transistors, RF	5.10-8-5.10-9
UHF, FM/AM Transmitter	4.7-10
Ultrafast Rectifiers	5.6-10
Undervoltage Sensing Circuit	4.2-30
Universal Cordless Phone Subsystem ICs	4.7-3
Universal Cordless Telephone Subsystem IC	4.7-4
Universal Cordless Telephone Subsystem IC with Scrambler	4.7-5
Universal Microprocessor Power Supply Controllers	4.2-23
Universal Motor Speed Controller	4.3-10
Universal Voltage Monitor	4.2-31

## V

VCO	3.1-39
Very High Voltage Single-Ended Controller with On-Chip Power Switch	4.2-15
Very High Voltage Switching Regulator	4.2-20, 4.2-21
VHF Transistors, RF	5.10-7-5.10-8
Video Capture Chip Sets	4.8-3
Video Circuits	4.8-3
Video Circuits - Miscellaneous	4.8-4
Video Data Converters	4.8-4
Voice Switched Speakerphone Circuit	4.7-25, 4.7-26, 4.7-28
Voice Switched Speakerphone with $\mu$ Processor Interface	4.7-27
Voice/Data Communication (Digital Transmission)	4.7-18
Voltage Controlled Oscillator	3.1-39
Voltage References Package Overview	4.4-2
Voltage Regulator/Supervisory	4.2-8
Voltage Regulators	4.9-2

## W

Wideband (FM/FSK) IFs	4.7-2
Wideband FM IF Subsystem	4.7-9
Wideband FM IF System	4.7-8
Wideband Linear Amplifiers, RF	5.10-34-5.10-35
Wideband Single Conversion Receivers - VHF	4.7-2
Worldwide Design Centers	1.1-8

## X

XNOR Gates	3.1-27
XOR Gates	3.1-27

## Z

Zener Diodes, Axial Leaded for Through-hole Designs	5.2-2, 5.2-19
Zener Diodes, Current Regulator	5.2-34
Zener Diodes, Surmetic 30	5.2-21
Zener Diodes, Voltage Reference	5.2-34
Zener Diodes, Voltage Regulator	5.2-19
Zero Voltage Controller	4.3-3
Zero Voltage Switch	4.3-2

# Subject Index

- A**
- Advanced Digital Consumer Products** ..... 1.0-1
    - Advanced Digital Consumer Division (ADCD)
      - New Market Focus ..... 1.1-1
    - H4EPlus Series Gate Arrays ..... 1.1-7
    - LCD Driver Product Summary ..... 1.1-3
    - Literature ..... 1.1-8
    - M5C Series Gate Arrays/M5CB Series Standard Cells ..... 1.1-6
    - Monitor On Screen Display (MOSD) ..... 1.1-4
    - MPC821/MPC823 RISC Microprocessors and the MC68328 DragonBall Integrated Processor ..... 1.1-2
    - Scorpion Graphics Processor (MC92100) ..... 1.1-5
    - Worldwide Design Centers ..... 1.1-8
  - Amplifier Modules** ..... 5.10-31-5.10-35
    - RF ..... 5.10-31-5.10-35
      - TV Transmitters ..... 5.10-35-5.10-36
      - Land Mobile/Portable ..... 5.10-31-5.10-33
      - Wideband Linear ..... 5.10-34-5.10-35
  - Amplifiers** ..... 5.10-29
    - RF ..... 5.10-29
      - CATV Distribution ..... 5.10-36-5.10-40
      - Integrated Power ..... 5.10-26
      - Modules ..... 5.10-31-5.10-35
  - Amplifiers and Comparators** ..... 4.1-1
    - Amplifiers and Comparators Package Overview ..... 4.1-8
    - Comparators ..... 4.1-7
      - Dual ..... 4.1-7
        - Bipolar ..... 4.1-7
        - CMOS ..... 4.1-7
      - Quad ..... 4.1-7
        - Bipolar ..... 4.1-7
        - CMOS ..... 4.1-7
      - Single ..... 4.1-7
        - Bipolar ..... 4.1-7
        - CMOS ..... 4.1-7
    - High Frequency Amplifiers ..... 4.1-5
      - AGC Amplifiers ..... 4.1-5
        - Family Wideband General Purpose ..... 4.1-5
    - Miscellaneous Amplifiers ..... 4.1-6
      - Bipolar ..... 4.1-6
        - Dual Operational Amplifier and Dual Voltage Comparator ..... 4.1-6
        - CMOS ..... 4.1-6
          - Dual Programmable Operational Amplifier and Dual Programmable Comparator ..... 4.1-6
          - Dual Video Amplifiers ..... 4.1-6
          - Quad Programmable Operational Amplifier ..... 4.1-6
    - Operational Amplifiers ..... 4.1-2
      - Dual Operational Amplifiers ..... 4.1-3
      - Quad Operational Amplifiers ..... 4.1-4
      - Single Operational Amplifiers ..... 4.1-2
  - Automotive Electronic Circuits** ..... 4.9-1
    - Alternator Voltage Regulator ..... 4.9-12
    - Automotive Direction Indicator ..... 4.9-9
    - Automotive Electronic Circuits Package Overview ..... 4.9-13
    - Automotive ISO 9141 Serial Link Driver ..... 4.9-11
    - Automotive Wash Wiper Timer ..... 4.9-10
    - Dual High-Side Switch ..... 4.9-6
    - Electronic Ignition ..... 4.9-2
    - High Side T MOS Driver ..... 4.9-8
    - Low Side Protected Switch ..... 4.9-7
    - MI-Bus Interface Stepper Motor Controller ..... 4.9-9
    - Octal Serial Switch ..... 4.9-5
    - Quad Fuel Injector Driver ..... 4.9-4
    - Special Functions ..... 4.9-3
    - Voltage Regulators ..... 4.9-2
- B**
- Bipolar Power Transistors** ..... 5.5-2
    - Audio ..... 5.5-15
    - Audio/Servo Loads ..... 5.5-15
    - DPAK-Surface Mount ..... 5.5-10
    - Electronic Lamp Ballasts ..... 5.5-16
    - Metal ..... 5.5-11
    - Plastic
      - TO-218 ..... 5.5-6
      - TO-220AB ..... 5.5-3
      - TO-225AA ..... 5.5-8
      - TO-247 ..... 5.5-7
      - TO-264 ..... 5.5-8
- C**
- Communication Circuits** ..... 4.7-1
    - Communications Circuits Package Overview ..... 4.7-41
    - Electronic Telephone ..... 4.7-19
      - The Complete Electronic Telephone Circuit ..... 4.7-19
    - ISDN Voice/Data Circuits ..... 4.7-15
      - Dual Data Link Controller ..... 4.7-17
      - Integrated Services Digital Network ..... 4.7-15
      - Second Generation S/T-Interface Transceivers ..... 4.7-16
      - Second Generation U-Interface Transceivers ..... 4.7-16
      - U-Interface Transceiver Evaluation Kit ..... 4.7-17
    - Narrowband FM Coilless Detector IF Subsystem ..... 4.7-7
    - Narrowband FM Receiver ..... 4.7-6
    - Phase-Locked Loop Components ..... 4.7-38
      - Phase-Locked Loop Functions ..... 4.7-39
      - PLL Frequency Synthesizers ..... 4.7-38
    - RF Communications ..... 4.7-2
      - Balanced Modulator/Demodulator ..... 4.7-4
      - Infrared Transceivers ..... 4.7-4
      - Narrowband Dual Conversion Receivers
        - FM/FSK - VHF ..... 4.7-3
      - Narrowband Single Conversion Receivers - VHF ..... 4.7-2
      - RF Front End ICs ..... 4.7-2
      - Transmitters - AM/FM/FSK ..... 4.7-3
      - Universal Cordless Phone Subsystem ICs ..... 4.7-3
      - Wideband (FM/FSK) IFs ..... 4.7-2
      - Wideband Single Conversion Receivers - VHF ..... 4.7-2
    - Speakerphones ..... 4.7-25
      - Telephone Line Interface and Speakerphone Circuit ..... 4.7-29
      - The Motorola Family of Speakerphone Integrated Circuits ..... 4.7-30
      - Voice Switched Speakerphone Circuit ..... 4.7-25, 4.7-26, 4.7-28
      - Voice Switched Speakerphone with  $\mu$ Processor Interface ..... 4.7-27
    - Speech Networks ..... 4.7-21
      - Cordless Universal Telephone Interface ..... 4.7-22
      - Programmable Telephone Line Interface Circuit with Loudspeaker Amplifier ..... 4.7-23
      - Telephone Line Interface ..... 4.7-24
      - Telephone Speech Network with Dialer Interface ..... 4.7-21
    - Telecommunications ..... 4.7-11
      - PBX Architecture (Analog Transmission) ..... 4.7-12
        - Dual Tone Multiple Frequency Receiver ..... 4.7-15
        - PCM Monocircuits Codec-Filters (CMOS LSI) ..... 4.7-12
      - Subscriber Loop Interface Circuit (SLIC) ..... 4.7-11
    - Telephone Accessory Circuits ..... 4.7-31
      - 300 Baud FSK Modems ..... 4.7-32
      - ADPCM Transcoder ..... 4.7-32
      - Audio Amplifier ..... 4.7-31
- 
- Motorola Master Selection Guide 7.2-9 Subject Index

# Subject Index

## C (continued)

### Communication Circuits (continued)

Calling Line ID Receiver Evaluation Kit .....	4.7-33
Calling Line Identification (CLID) Receiver with Ring Detector .....	4.7-33
Continuously Variable Slope Delta (CVSD) Modulator/Demodulator .....	4.7-34
Current Mode Switching Regulator .....	4.7-31
Summary of Bipolar Telecommunication Circuits .....	4.7-35
Tone Ringers .....	4.7-20
UHF, FM/AM Transmitter .....	4.7-10
Universal Cordless Telephone Subsystem IC .....	4.7-4
Universal Cordless Telephone Subsystem IC with Scrambler .....	4.7-5
Voice/Data Communication (Digital Transmission) .....	4.7-18
2-Wire ISDN Universal Digital Loop Transceiver II (UDLT II) .....	4.7-19
2-Wire Universal Digital Loop Transceiver (UDLT) .....	4.7-18
Wideband FM IF Subsystem .....	4.7-9
Wideband FM IF System .....	4.7-8

### Communications, Power and Signal Technologies Group .....

## D (continued)

### Data Conversion .....

A-D Converters .....	4.5-1
Bipolar .....	4.5-2
CMOS .....	4.5-2
Sigma-Delta .....	4.5-2
D-A Converters .....	4.5-3
CMOS .....	4.5-3
Sigma-Delta .....	4.5-3
Data Conversion Package Overview .....	4.5-4

### Development Tools .....

Digital Signal Processors .....	2.1-1
Design-In Software .....	2.1-19
LonWorks Products .....	2.7-1, 2.7-2
Developer's Workbench .....	2.7-6
Support Tools .....	2.7-7

### Discrete Products .....

RF .....	5.0-1
5.10-1	

### DO-204AA (DO-7) .....

Tuning and Switching Diodes, Small Signal .....	5.1-26, 5.1-32
Zener Diodes .....	5.2-34

### DO-204AH (DO-35), Zener Diodes .....

5.2-19, 5.2-34	
----------------	--

### DPAK .....

5.4-10, 5.5-10, 5.6-5	
Bipolar Power Transistors .....	5.5-10
Rectifiers .....	5.6-5, 5.6-10
TMOS Power MOSFETs .....	5.4-10, 5.4-18, 5.4-20

## E

### Evaluation Boards, RF Monolithic

Integrated Circuits .....	5.10-23
---------------------------	---------

### EZFETs .....

Power MOSFETs .....	5.4-9
---------------------	-------

## F

### Fiber Optic Receivers, RF .....

5.10-36	
---------	--

### Field Programmable Gate Arrays (FPGA) .....

3.1-5	
-------	--

### Field-Effect Transistors .....

5.1-1, 5.1-20, 5.4-1	
JFETs, Small Signal .....	5.1-20
MOSFETs, Small Signal .....	5.1-22, 5.1-42
Power MOSFETs .....	5.4-1
Surface Mount FETs, Small Signal .....	5.1-23

## G

### GaAs Rectifiers Power Manager .....

5.6-14	
--------	--

## H

### HDTMOS Power MOSFETs

EZFET .....	5.4-4, 5.4-17
High Power	
D2PAK .....	5.4-3
DPAK .....	5.4-3
TO-220 .....	5.4-3
Micro8 .....	5.4-4, 5.4-17
SO-8 .....	5.4-4

### High Cell Density (Power MOSFETs) .....

5.4-3	
-------	--

### Hybrid Power Modules .....

Integrated Power Stage IGBTs .....	5.3-2
------------------------------------	-------

## I

### IGBTs .....

5.3-2, 5.4-7	
Hybrid Power Modules .....	5.3-2
Power MOSFETs .....	5.4-7, 5.4-22

## D

### D2PAK .....

5.4-11, 5.6-5	
Rectifiers .....	5.6-5, 5.6-10
TMOS Power MOSFETs .....	5.4-11, 5.4-19, 5.4-21

### D3PAK .....

5.4-12	
TMOS Power MOSFETs .....	5.4-12

# Subject Index

## I (continued)

- Ignition IGBTs** ..... 5.4-7
  - TMOS Power MOSFETs ..... 5.4-7, 5.4-22
- Insulated Gate Bipolar Transistors** ..... 5.3-2, 5.4-7
  - Integrated Power Stage IGBTs, Hybrid Power Modules .. 5.3-2
  - TMOS ..... 5.4-7
- Integrated Circuits, Monolithic** ..... 5.10-23-5.10-28
  - RF ..... 5.10-23-5.10-28
    - Evaluation Boards ..... 5.10-23
    - Receiver Functions ..... 5.10-24-5.10-25
    - Switching ..... 5.10-24
    - Transmitter Functions ..... 5.10-25-5.10-27
- Interface Circuits** ..... 4.6-1
  - 5.0 V, 200 M-Bit/Sec PR-IV Hard Disk
    - Drive Read Channel ..... 4.6-5
  - CMOS Display Drivers ..... 4.6-9
    - Display Drivers ..... 4.6-9
    - Functions ..... 4.6-9
  - Enhanced Ethernet Transceiver ..... 4.6-2
  - Hex EIA-485 Transceiver with Three-State Outputs .... 4.6-4
  - Inkjet Drivers ..... 4.6-8
    - 28-Channel Inkjet Driver ..... 4.6-8
  - Interface Circuits Package Overview ..... 4.6-10
  - ISO 8802-3 [IEEE 802.3] 10BASE-T Transceiver ..... 4.6-3
  - Line Drivers ..... 4.6-7
    - EIA Standard ..... 4.6-7
    - EIA-232-E/V.28 CMOS Drivers/Receivers ..... 4.6-7
    - IEEE 802.3 Transceivers ..... 4.6-8
    - Line Transceivers ..... 4.6-7
    - Peripheral Drivers ..... 4.6-8
  - Line Receivers ..... 4.6-7
    - EIA Standard ..... 4.6-7
  - Read/Write Channel ..... 4.6-8
  - Read/Write Channels, Hard Disk Drive Read Channel ... 4.6-8

## L

- Linear Amplifiers, Wideband** ..... 5.10-34-5.10-35
  - RF ..... 5.10-34-5.10-35
- Logic Integrated Circuits**
  - Motorola Logic Families, Which Is Best for You? ..... 3.1-1
  - Programmable Logic ..... 3.1-5
- Logic Level Power MOSFETs** ..... 5.4-20, 5.4-21

## M

- Medium Power MOSFETs, TMOS** ..... 5.4-9, 5.4-18
- Mfax - Touch-Tone FAX for Technical Data** ..... 6.1-1
- Micro-8** ..... 5.10-24
  - RF ..... 5.10-24
- Micro8 Products** ..... 5.4-8
- Microcomputer Components**
  - Fuzzy Logic ..... 2.6-26
  - M68000 Family
    - Coprocessors ..... 2.2-10
    - Data Communication Devices ..... 2.2-12
    - DMA Controllers ..... 2.2-10
    - Embedded Controllers ..... 2.2-5
    - Fiber Distributed Data Interface ..... 2.2-13
    - General Purpose I/O ..... 2.2-12
    - Integrated Processors ..... 2.2-7
    - Microprocessors ..... 2.2-1, 2.2-2
    - Network Devices ..... 2.2-10
  - M88000 RISC Family ..... 2.3-1

## M (continued)

### Microcomputer Components (continued)

- Cache/Memory Management Units ..... 2.3-3
- Microprocessors ..... 2.3-2
- Memory Products ..... 2.8-1
  - Dynamic RAMs ..... 2.8-7
    - HCMOS ..... 2.8-8
    - Modules ..... 2.8-9
  - Fast Static RAMs ..... 2.8-2
    - Asynchronous ..... 2.8-5
    - Synchronous ..... 2.8-3
    - Modules ..... 2.8-6
  - Flash Memory ..... 2.8-7
- Microcontroller Development Tools ..... 2.5-14, 2.6-22
- On-Line Help ..... 2.5-23, 2.6-26
- PowerPC RISC Family ..... 2.4-1
  - MPC105 PCI Microprocessor ..... 2.4-15
  - MPC106 PCI Microprocessor ..... 2.4-16
  - MPC601 RISC Microprocessor ..... 2.4-2
  - MPC602 RISC Microprocessor ..... 2.4-3
  - MPC603 RISC Microprocessor ..... 2.4-3
  - MPC603e RISC Microprocessor ..... 2.4-6
  - MPC604 RISC Microprocessor ..... 2.4-9
  - MPC604e RISC Microprocessor ..... 2.4-9
  - MPC620 RISC Microprocessor ..... 2.4-13
- Single-Chip Microcontrollers (MCU) ..... 2.5-1, 2.6-1
  - Configuration and Order Information for MMDS/MMEVS ..... 2.5-14
  - Configuration and Order Information for Other Motorola Development Tools (EVM/EVS/ICS) ..... 2.5-17
  - Configuration and Order Information for Programmable ..... 2.5-18
- M6800 Series Microprocessors and Peripherals ..... 2.6-10
- M68300 Family ..... 2.6-19
- M68HC05 CSIC Family ..... 2.5-2
- M68HC08 Family ..... 2.5-13
- M68HC11 Family ..... 2.6-2
- M68HC16 Family ..... 2.6-14
- MC68HC05 Microcontrollers ..... 2.5-6
- Modular Microcontrollers ..... 2.6-12
- One-Time Programmable (OTP) / Emulator MCUs ..... 2.5-9
- Third Party Developers for 68HC05 and 68HC705 Family MCUs ..... 2.5-19
- Third-Party Support ..... 2.6-27
- Mini Mosorb** ..... 5.2-2
  - Transient Voltage Suppressors .. 5.2-2, 5.2-13, 5.2-15, 5.2-16
- Minimos Products** ..... 5.4-8, 5.4-17
- MOSFETs, Power, TMOS** ..... 5.4-1
- Mosorb** ..... 5.2-6
  - Transient Voltage Suppressors ..... 5.2-6
- Motorola Programmable Array (MPA)** ..... 3.1-5
- Motorola SPS World Marketing Internet Server** ..... 6.1-1
- Motorola Technical Training Courses** ..... 6.1-7

## O

- Optoelectronic Devices** ..... 5.8-1, 5.8-10
  - Optoisolators ..... 5.8-1, 5.8-2, 5.8-5
  - POWER OPTO Isolators ..... 5.8-1, 5.8-10
- Optoisolators** ..... 5.8-1, 5.8-2
- Other Analog Circuits** ..... 4.10-1
  - Multipliers ..... 4.10-2
    - Linear Four-Quadrant Multipliers ..... 4.10-2
  - Other Analog Circuits Package Overview ..... 4.10-4
  - Smoke Detectors (CMOS) ..... 4.10-3

# Subject Index

## O (continued)

### Other Analog Circuits (continued)

Timing Circuits	4.10-2
Duals	4.10-2
Singles	4.10-2

## P

### Packaging Specifications, CPSTG

Adhesion Pull Tests	5.12-9
Fan Fold Box Styles	5.12-9
TO-92 EIA Radial Tape	5.12-7

### PPF-16

RF	5.10-26
----	---------

### PLD-1

RF	5.10-15
----	---------

### PLD-1.5

RF	5.10-5
----	--------

### Power MOSFETs, TMOS

	5.4-1
--	-------

### POWER OPTO Isolators

	5.8-1, 5.8-10
--	---------------

### Power Supply Circuits

Battery Management Circuits	4.2-32
Battery Charger ICs	4.2-32
Battery Fast Charge Controller	4.2-32
Power Supply, Battery Charger, Regulation Control Circuit	4.2-33
Battery Pack ICs	4.2-34
Lithium Battery Protection Circuit for One Cell Battery Packs	4.2-37
Lithium Battery Protection Circuit for One or Two Cell Battery Packs	4.2-36
Lithium Battery Protection Circuit for One to Four Cell Battery Packs	4.2-34
Lithium Battery Protection Circuit for Three to Four Cell Battery Packs	4.2-35

### Linear Voltage Regulators

Adjustable Output	4.2-4
Adjustable Output Regulators	4.2-4
Fixed Output	4.2-2
Fixed Voltage Medium and Low Dropout Regulators	4.2-3
Linear Voltage Regulators	4.2-2

### Micropower Voltage Regulators for Portable Applications

120 mA Micropower Voltage Regulator	4.2-6
80 mA Micropower Voltage Regulator	4.2-5
Micropower Voltage Regulator for External Power Transistor	4.2-6
Micropower Voltage Regulators with On/Off Control	4.2-7

### MOSFET/IGBT Drivers

High Speed Dual Drivers	4.2-38
Inverting	4.2-38
Noninverting	4.2-38
Single IGBT Driver	4.2-38
Single IGBT Gate Driver	4.2-39

### Power Supply Circuits Package Overview

Special Regulators	4.2-8
SCSI Regulator	4.2-11
Voltage Regulator/Supervisory	4.2-8
Special Switching Regulator Controllers	4.2-23
Dual Channel Controllers	4.2-23
Power Factor Controllers	4.2-24, 4.2-25
Universal Microprocessor Power Supply Controllers	4.2-23

### Supervisory Circuits

CMOS Micropower Undervoltage Sensing Circuits	4.2-28
CMOS Micropower Undervoltage Sensing Circuits with Output Delay	4.2-29
Over/Undervoltage Protection Circuit	4.2-27

## P (continued)

### Power Supply Circuits (continued)

Overvoltage Crowbar Sensing Circuit	4.2-27
Undervoltage Sensing Circuit	4.2-30
Universal Voltage Monitor	4.2-31
Switching Regulator Control Circuits	4.2-12
CMOS Micropower DC-to-DC Converters	4.2-16
Fixed Frequency PWM Micropower DC-to-DC Converter	4.2-17
Variable Frequency Micropower DC-to-DC Converter	4.2-16
Critical Conduction SMPS Controller	4.2-22
Double-Ended Controllers	4.2-15
Easy Switcher Single-Ended Controllers with On-Chip Power Switch	4.2-14
Single-Ended Controllers	4.2-12
Single-Ended Controllers with On-Chip Power Switch	4.2-14
Single-Ended GreenLine Controllers	4.2-18
High Safety Latched Mode GreenLine PWM Controller for (Multi)Synchronized Applications	4.2-19
High Safety Standby Ladder Mode GreenLine PWM Controller	4.2-18
Mixed Frequency Mode GreenLine PWM Controller	4.2-18
Very High Voltage Single-Ended Controller with On-Chip Power Switch	4.2-15
Very High Voltage Switching Regulator	4.2-20, 4.2-21
Voltage Regulator/Supervisory	
GaAs Power Amplifier Support IC	4.2-10
Low Dropout Regulator	4.2-9
Microprocessor Voltage Regulator and Supervisory Circuit	4.2-9
Power Management Controller	4.2-10

### Power/Motor Control Circuits

Motor Controllers	4.3-4
Brushless DC Motor Controllers	4.3-4
Closed Loop Brushless Motor Adapter	4.3-7
DC Servo Motor Controller/Driver	4.3-8
Stepper Motor Driver	4.3-9
Universal Motor Speed Controller	4.3-10
Power Controllers	4.3-2
High-Side Driver Switch	4.3-4
Zero Voltage Controller	4.3-3
Zero Voltage Switch	4.3-2
Power/Motor Control Circuits Package Overview	4.3-11

### PowerPC RISC Microprocessors

	2.4-2
--	-------

### POWERTAP II, Rectifiers

	5.6-9, 5.6-12
--	---------------

### Processors, Digital Signal Processors

16-Bit	2.1-1
24-Bit	2.1-3
32-Bit	2.1-17
Peripherals	2.1-5, 2.1-12, 2.1-19

## R

### Receiver Functions

RF	5.10-24
1.5 - 2.2 GHz Front End	5.10-24
2.4 GHz Front End	5.10-25
900 MHz Front End	5.10-24

### Rectifier Numbering System

	5.6-2
--	-------

### Rectifiers

Application Specific	5.6-3
Automotive Transient Suppressors	5.6-3
Low VF Schottky	5.6-3
MEGAHERTZ Rectifiers	5.6-3

# Subject Index

## R (continued)

### Rectifiers (continued)

SCANSWITCH Rectifiers	5.6-3
Fast Recovery	5.6-13
GaAs Rectifiers Power Manager	5.6-14
General Purpose Rectifiers	5.6-13
SWITCHMODE Rectifiers	5.6-4
Axial Lead Schottky	5.6-6
POWERTAP II	5.6-9
Surface Mount Schottky	5.6-4
TO-218 Types and TO-247 Schottky	5.6-8
TO-220 Type Schottky	5.6-7
Ultrafast Rectifiers	5.6-10
Axial Lead	5.6-10
POWERTAP II	5.6-12
Surface Mount	5.6-10
TO-218 Types	5.6-12
TO-220 Type	5.6-11
TO-247	5.6-12

### RF Products

<b>RF, LDMOS</b>	<b>5.10-5-5.10-6</b>
Amplifier Modules	5.10-31-5.10-34
High Power Discrete Transistors	5.10-5-5.10-6
Medium Power Discrete Transistors	5.10-15
Monolithic Integrated Circuits	5.10-26

## S

### SC-59

Bipolar Transistors, Small Signal	5.1-11
Switching Diodes, Small Signal	5.1-36

### SC-70/SOT-323

Bipolar Transistors, Small Signal	5.1-11
RF	5.10-19-5.10-20
Schottky Diodes, Small Signal	5.1-34
Switching Diodes, Small Signal	5.1-36
Tuning Diodes, Small Signal	5.1-31
VHF/UHF Amplifiers, Mixers, Oscillators, Small Signal	5.1-14

### SC-70ML/SOT-363

RF	5.10-19
----	---------

### Sensors

Acceleration	5.9-12
Gas	5.9-12
Pressure	5.9-2
Compensated and Calibrated	5.9-7, 5.9-8
High Impedance	5.9-7, 5.9-9
Signal Conditioned	5.9-7, 5.9-9
Uncompensated	5.9-7, 5.9-8

### Silicon Controlled Rectifiers

Thyristors	5.7-2
------------	-------

### SMA

TVS/Zeners	5.2-11, 5.2-24
------------	----------------

### Small Signal GreenLine Devices

Integrated Relay/Solenoid Driver	5.1-43
Low-Voltage Bias Stabilizer	5.1-43

### Small Signal Transistors

Bipolar Transistors	5.1-1, 5.1-2
Metal-Can	5.1-2, 5.1-41
Plastic-Encapsulated	5.1-18
Plastic-Encapsulated	5.1-2, 5.1-8, 5.1-10, 5.1-41

### Small Signal Tuning and Switching Diodes

Abrupt Junction	5.1-25
Hyper-Abrupt Junction	5.1-29
Multiple Switching	5.1-39

## S (continued)

### Small Signal Tuning and Switching Diodes (continued)

Schottky	5.1-33
Switching	5.1-35, 5.1-42

### SMARTDISCRETES Products

Ignition IGBTs	5.4-7
TO-220AB	5.4-7

### SMB

Rectifiers	5.2-13, 5.6-4
TVS/Zeners	5.6-4, 5.6-10

### SMB

Rectifiers	5.2-16, 5.6-4
Transient Voltage Suppressors	5.6-4, 5.6-10

### SO-14

Multiple Switching Diodes, Small Signal	5.1-40
---	--------

### SO-16

Bipolar Transistors, Small Signal	5.10-24-5.10-25
Multiple Switching Diodes, Small Signal	5.1-40
RF	5.10-24-5.10-28

### SO-8

Optoisolators	5.8-9
RF	5.10-9, 5.10-15, 5.10-19-5.10-27
Thyristors	5.7-14
TMOS Power MOSFETs	5.4-8, 5.4-17

### SOD-123

Rectifiers	5.2-29, 5.6-4
TVS/Zeners	5.6-4

### SOD-123

Rectifiers	5.2-24, 5.2-29
------------	----------------

### SOT-143

RF	5.1-43, 5.10-15, 5.10-19-5.10-21
Small Signal	5.10-15, 5.10-19-5.10-21, 5.10-24-5.10-25

### SOT-223

Bipolar Transistors, Small Signal	5.1-16
FETs, Small Signal	5.1-24, 5.1-42
Thyristors	5.7-2
Tuning and Switching Diodes, Small Signal	5.1-32

### SOT-23

Bipolar Transistors, Small Signal	5.1-18
FETs, Small Signal	5.1-23, 5.1-42
Multi-integrated Devices, Small Signal	5.1-43
RF	5.10-18, 5.10-21-5.10-22
Schottky Diodes, Small Signal	5.1-34
Switching Diodes, Small Signal	5.1-37, 5.1-42
Tuning Diodes, Small Signal	5.1-28
TVS/Zeners	5.2-9, 5.2-27

### SOT-363

FETs, Small Signal	5.1-11, 5.1-43
Plastic-Encapsulated Surface Mount Transistors, Small Signal	5.1-23
Schottky Diodes, Small Signal	5.1-11
Small Signal	5.1-34
Small Signal	5.1-43

### SOT-416/SC-90

Plastic-Encapsulated Surface Mount Transistors, Small Signal	5.1-12
Switching Diodes, Small Signal	5.1-37

### SOT-89

RF	5.10-15
----	---------

### Surface Mount Information, CPSTG

Footprints for Soldering	
D2PAK	5.11-5
D3PAK	5.11-5
DPAK	5.11-5
MICRO8	5.11-5
OPTO SO-8	5.11-5
SC-59	5.11-5

# Subject Index

## S (continued)

### Surface Mount Information, CPSTG (continued)

SC-70/SOT-323	5.11-5
SC-90	5.11-5
SMA	5.11-5
SMB	5.11-5
SMC	5.11-5
SO-14	5.11-5
SO-16	5.11-5
SO-8	5.11-5
SOD-123	5.11-5
SOT-143	5.11-5
SOT-223	5.11-5
SOT-23	5.11-5
SOT-363	5.11-5
TSSOP-6	5.11-5
Using Surface Mount Packages	5.11-2

### Surface Mount Products, CPSTG 5.1-9, 5.1-43, 5.2-9, 5.2-11, 5.2-13, 5.4-8, 5.5-10, 5.6-4, 5.10-9

Bipolar Power Transistors	5.5-10
DPAK	5.5-10
Rectifiers	5.6-4
D2PAK	5.6-5, 5.6-10
DPAK	5.6-5, 5.6-10
SMB	5.6-4, 5.6-10
SMC	5.6-4, 5.6-10
RF	5.10-9
Micro-8	5.10-24
PFP-16	5.10-26
PLD-1	5.10-15
PLD-1.5	5.10-5
SC-70/SOT-323	5.10-19-5.10-20
SC-70ML/SOT-363	5.10-19
SO-16	5.10-24-5.10-28
SO-8	5.10-9, 5.10-15, 5.10-19-5.10-27
SOT-143	5.10-15, 5.10-19-5.10-21, 5.10-24-5.10-25
SOT-23	5.10-18, 5.10-21-5.10-22
TQFP-48	5.10-24
TSSOP-16	5.10-24-5.10-25, 5.10-27-5.10-28
TSSOP-16HS	5.10-27
TSSOP-20	5.10-25
TSSOP-20HS	5.10-28
Small Signal	5.1-9, 5.1-43
SC-59	5.1-11, 5.1-36, 5.1-42
SC-70/SOT-323	5.1-11, 5.1-14, 5.1-24, 5.1-36, 5.1-42
SO-16	5.1-9
SOD-123	5.1-42
SOT-143	5.1-43
SOT-223	5.1-17, 5.1-24
SOT-23	5.1-10, 5.1-23, 5.1-36, 5.1-37, 5.1-43
SOT-363	5.1-11, 5.1-23, 5.1-34, 5.1-43
SOT-416/SC-90	5.1-12, 5.1-37
Thyristors, SOT-223	5.7-7
TMOS Power MOSFETs	5.4-8
D2PAK	5.4-11, 5.4-19, 5.4-21
D3PAK	5.4-12
DPAK	5.4-10, 5.4-18, 5.4-20
SO-8	5.4-8, 5.4-17
SOT-223	5.4-9, 5.4-18, 5.4-20
TVS/Zeners	5.2-9, 5.2-11, 5.2-13
SMA	5.2-11, 5.2-24
SMB	5.2-13, 5.2-24
SMC	5.2-16
SOD-123	5.2-24, 5.2-29
SOT-23	5.2-9, 5.2-24, 5.2-27

## S (continued)

Surface Mount Products, Discrete	5.8-5, 5.8-9
Optoisolators	5.8-5, 5.8-9
6-Pin Devices	5.8-5
SO-8	5.8-9
Surmetic 30	5.2-21
Zener Diodes	5.2-21
Surmetic 40	5.2-21
Transient Voltage Suppressors	5.2-4, 5.2-21
Switching	5.10-24
RF	5.10-24
SWITCHMODE Rectifiers	
Axial Lead Schottky	5.6-6
POWERTAP II	5.6-9
Surface Mount Schottky	5.6-4
TO-218 Types and TO-247 Schottky	5.6-8
TO-220 Type Schottky	5.6-7

## T

Tape and Reel Options	4.11-1
Analog MPQ Table	4.11-5
Tape/Reel and Ammo Pack	4.11-5
D2PAK	4.11-5
DPAK	4.11-5
Micro-8	4.11-5
PLCC	4.11-5
SOIC	4.11-5
SOT-23 (5 Pin)	4.11-5
SOT-89 (3 Pin)	4.11-5
SOT-89 (5 Pin)	4.11-5
TO-92	4.11-5
Tape and Reel Configurations	4.11-2
Tape and Reel Information Table	4.11-4
Tape and Reel Specifications, CPSTG	5.12-2
Embossed Tape and Reel Data	5.12-4
Embossed Tape and Reel Ordering Information	5.12-3
Lead Tape Packaging Specifications for Axial-Lead Components	5.12-6
Technical Data and Literature	6.1-2, 6.1-6
Technical Data Services	
"IMAGINE" SPS Customer Magazine	6.1-1
Mfax - Touch-Tone FAX	6.1-1
Motorola SPS World Marketing Internet Server	6.1-1
Technical Training, Technical Training Centers	6.1-13
Thyristors	5.7-2
Silicon Controlled Rectifiers	5.7-2
General Purpose, Plastic	5.7-2
TRIACs	5.7-7
General Purpose, Plastic	5.7-7
Triggers	
High Voltage Bidirectional TVS Devices	5.7-14
Programmable Unijunction Transistors	5.7-14
SIDACs	5.7-14
Silicon Bidirectional Switch	5.7-14
TMOS MOSFETs	5.1-22
Small Signal	5.1-22, 5.1-42
TMOS Power MOSFETs	5.4-1
TMOS Power MOSFETs Numbering System	5.4-2
TMOS V	5.4-5
TO-116	
Bipolar Transistors, Small Signal	5.1-9
Multiple Switching Diodes, Small Signal	5.1-40



# Subject Index

## T (continued)

<b>TO-205AD (TO-39)</b> .....	<b>5.1-18</b>
Bipolar Transistors, Small Signal .....	5.1-18
<b>TO-206AA (TO-18)</b> .....	<b>5.1-18</b>
Bipolar Transistors, Small Signal .....	5.1-18
<b>TO-218</b> .....	<b>5.6-8</b>
Rectifiers .....	5.6-8, 5.6-12
<b>TO-220 Types</b> .....	<b>5.6-7</b>
Rectifiers .....	5.6-7, 5.6-11
<b>TO-220AB</b> .....	<b>5.4-13, 5.4-19</b>
Thyristors .....	5.7-4, 5.7-8
TMOS Power MOSFETs .....	5.4-13, 5.4-19, 5.4-21
<b>TO-225AA (TO-126)</b> .....	<b>5.7-3</b>
Thyristors .....	5.7-3, 5.7-7
<b>TO-226AA (TO-92)</b>	
Bipolar Transistors, Small Signal .....	5.1-2
JFETs, Small Signal .....	5.1-20
Thyristors .....	5.7-2, 5.7-7, 5.7-14
TMOS MOSFETs, Small Signal .....	5.1-22
Tuning and Switching Diodes, Small Signal .....	5.1-25, 5.1-28, 5.1-35
<b>TO-226AC (TO-92)</b>	
Schottky Diodes, Small Signal .....	5.1-34
Tuning and Switching Diodes, Small Signal .....	5.1-27, 5.1-31, 5.1-36
<b>TO-226AE (TO-92)</b>	
Bipolar Transistors, Small Signal .....	5.1-3
TMOS MOSFETs, Small Signal .....	5.1-22
<b>TO-236AB</b>	
Bipolar Transistors, Small Signal .....	5.1-10
FETs, Small Signal .....	5.1-23
Schottky Diodes, Small Signal .....	5.1-34
Tuning and Switching Diodes, Small Signal .....	5.1-31, 5.1-36, 5.1-42
<b>TO-247</b> .....	<b>5.4-15, 5.6-8</b>
Rectifiers .....	5.6-8, 5.6-12
TMOS Power MOSFETs .....	5.4-15
<b>TO-264 High Power Products</b> .....	<b>5.4-16</b>
TMOS Power MOSFETs .....	5.4-16
<b>TO-3PBL</b> .....	<b>5.4-16</b>
TMOS Power MOSFETs .....	5.4-16
<b>TQFP-48</b> .....	<b>5.10-24</b>
RF .....	5.10-24
<b>Transceivers, Digital Signal Processors</b> .....	<b>2.1-1</b>
<b>Transient Voltage Suppressors</b> .....	<b>5.2-2</b>
Axial Leaded for Through-hole Designs .....	5.2-2
<b>Transistors, Discrete</b> .....	<b>5.10-2</b>
RF .....	5.10-2
Medium Power .....	5.10-14-5.10-16
Power Bipolar .....	5.10-7-5.10-14
1.5 GHz .....	5.10-10
900 MHz .....	5.10-9-5.10-10

## T (continued)

<b>Transistors, Discrete (continued)</b>	
HF .....	5.10-7
Linear .....	5.10-12-5.10-13
Microwave .....	5.10-10-5.10-11
UHF .....	5.10-8-5.10-9
VHF .....	5.10-7-5.10-8
Power MOSFETs .....	5.10-4-5.10-5
Small Signal .....	5.10-16-5.10-21
<b>Transmitter Functions</b> .....	<b>5.10-25</b>
RF .....	5.10-25
1.5 - 2.2 GHz Transmit Chain .....	5.10-27-5.10-28
2.4 GHz Transmit Chain .....	5.10-28
900 MHz Transmit Chain .....	5.10-26-5.10-27
<b>TRIACs</b> .....	<b>5.7-7</b>
Thyristors .....	5.7-7
<b>TSSOP-16</b> .....	<b>5.10-24-5.10-25</b>
RF .....	5.10-24-5.10-25, 5.10-27-5.10-28
<b>TSSOP-16HS, RF</b> .....	<b>5.10-27</b>
<b>TSSOP-20</b> .....	<b>5.10-25</b>
RF .....	5.10-25
<b>TSSOP-20HS</b> .....	<b>5.10-28</b>
RF .....	5.10-28
<b>TVS/Zeners</b> .....	<b>5.2-1</b>
Transient Voltage Suppressors .....	5.2-2
General-Purpose .....	5.2-2
Overvoltage Transient .....	5.2-18
Surface Mount .....	5.2-9
Zener Diodes .....	5.2-19
Current Regulator .....	5.2-34
Voltage Reference .....	5.2-34
Voltage Regulator .....	5.2-19

## U

<b>Ultrafast Rectifiers</b> .....	<b>5.6-10</b>
Axial Lead .....	5.6-10
POWER TAP II .....	5.6-12
Surface Mount .....	5.6-10
TO-218 Types .....	5.6-12
TO-220 Type .....	5.6-11
TO-247 .....	5.6-12

## V

<b>Voltage References</b> .....	<b>4.4-1</b>
Precision Low Voltage References .....	4.4-2
Voltage References Package Overview .....	4.4-2

## Z

<b>Zener Diodes</b>	
Current Regulator .....	5.2-34
Voltage Reference .....	5.2-34
Voltage Regulator .....	5.2-19
Axial Leaded for Through-hole Designs .....	5.2-2, 5.2-19
Surface Mount Packages .....	5.2-24



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# Introduction

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**1** Advanced Digital  
Consumer Products

---

**2** Microcomputer Components

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**3** Logic: Standard, Special  
and Programmable

---

**4** Analog and Interface  
Integrated Circuits

---

**5** Communications, Power and  
Signal Technologies Group Products

---

**6** Product Literature and  
Technical Training

---

**7** Device Index and  
Subject Index

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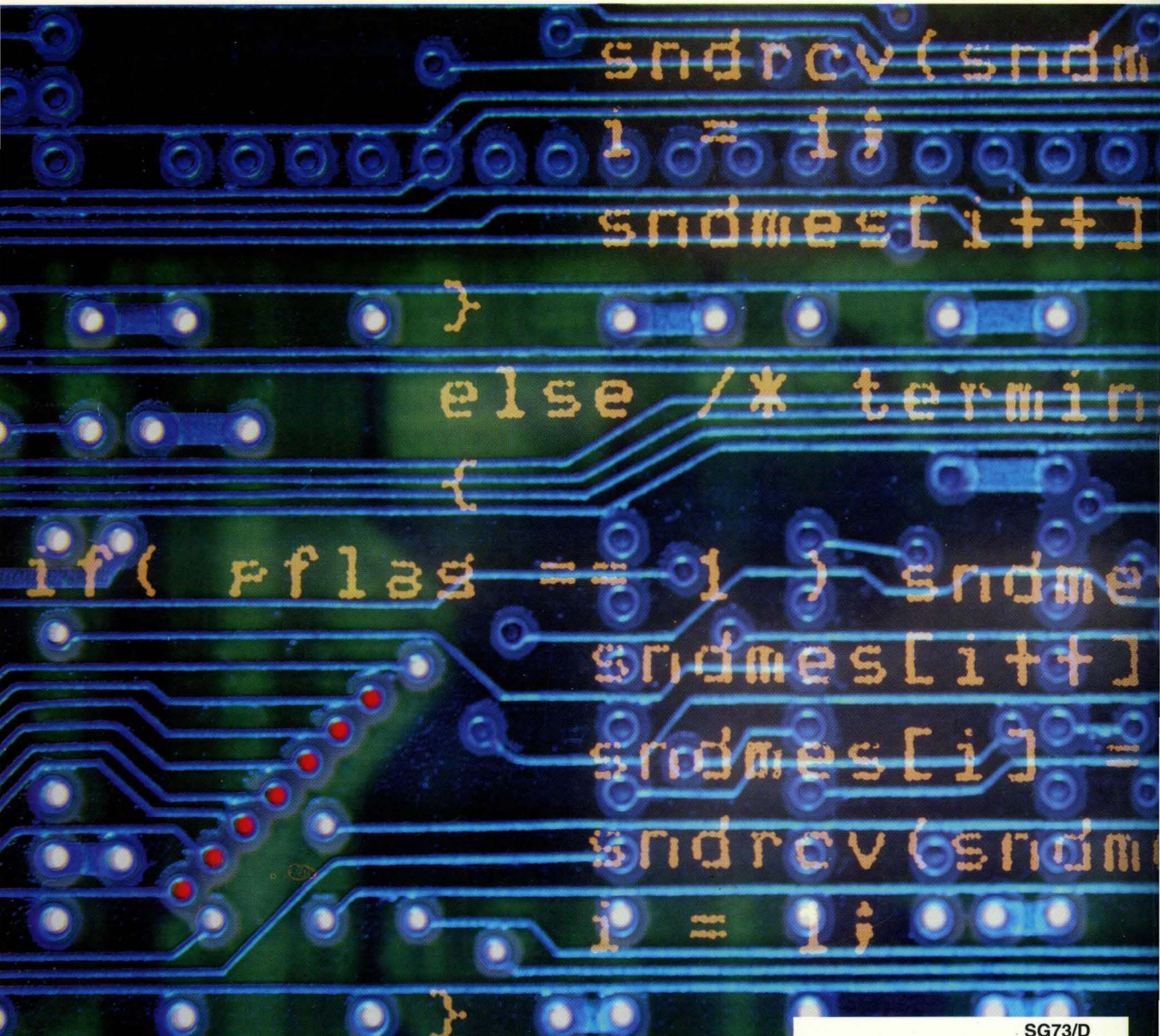
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